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April 1st, 2010
Renesas Electronics Corporation

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The revision list can be viewed directly by clicking the title page.

The revision list summarizes the locations of revisions and additions. Details should always be checked by referring to the relevant text.

H8S/2138 Group, H8S/2134 Group, H8S/2138F-ZTAT™, H8S/2134F-ZTAT™, H8S/2132F-ZTAT™

Hardware Manual

Renesas 16-Bit Single-Chip Microcomputer H8S Family/H8S/2100 Series

| | | | |
|----------|-------------|----------|-------------|
| H8S/2138 | HD6432138S | H8S/2134 | HD6432134S |
| | HD6432138SW | | HD64F2134 |
| | HD64F2138 | | HD64F2134V |
| | HD64F2138V | | HD64F2134A |
| | HD64F2138A | | HD64F2134AV |
| | HD64F2138AV | H8S/2133 | HD6432133S |
| H8S/2137 | HD6432137S | H8S/2132 | HD6432132 |
| | HD6432137SW | | HD64F2132R |
| | | | HD64F2132RV |
| | | H8S/2130 | HD6432130 |

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General Precautions on Handling of Product

1. Treatment of NC Pins

Note: Do not connect anything to the NC pins.

The NC (not connected) pins are either not connected to any of the internal circuitry or are used as test pins or to reduce noise. If something is connected to the NC pins, the operation of the LSI is not guaranteed.

2. Treatment of Unused Input Pins

Note: Fix all unused input pins to high or low level.

Generally, the input pins of CMOS products are high-impedance input pins. If unused pins are in their open states, intermediate levels are induced by noise in the vicinity, a pass-through current flows internally, and a malfunction may occur.

3. Processing before Initialization

Note: When power is first supplied, the product's state is undefined.

The states of internal circuits are undefined until full power is supplied throughout the chip and a low level is input on the reset pin. During the period where the states are undefined, the register settings and the output state of each pin are also undefined. Design your system so that it does not malfunction because of processing while it is in this undefined state. For those products which have a reset function, reset the LSI immediately after the power supply has been turned on.

4. Prohibition of Access to Undefined or Reserved Addresses

Note: Access to undefined or reserved addresses is prohibited.

The undefined or reserved addresses may be used to expand functions, or test registers may have been allocated to these addresses. Do not access these registers; the system's operation is not guaranteed if they are accessed.

Configuration of This Manual

This manual comprises the following items:

1. General Precautions on Handling of Product
2. Configuration of This Manual
3. Preface
4. Main Revisions for This Edition

The list of revisions is a summary of points that have been revised or added to earlier versions. This does not include all of the revised contents. For details, see the actual locations in this manual.

5. Contents
6. Overview
7. Description of Functional Modules
 - CPU and System-Control Modules
 - On-Chip Peripheral Modules

The configuration of the functional description of each module differs according to the module. However, the generic style includes the following items:

- i) Feature
- ii) Input/Output Pin
- iii) Register Description
- iv) Operation
- v) Usage Note

When designing an application system that includes this LSI, take notes into account. Each section includes notes in relation to the descriptions given, and usage notes are given, as required, as the final part of each section.

8. List of Registers
9. Electrical Characteristics
10. Appendix

Preface

The H8S/2138 Group and H8S/2134 Group comprise high-performance microcomputers with a 32-bit H8S/2000 CPU core, and a set of on-chip supporting functions required for system configuration.

The H8S/2000 CPU can execute basic instructions in one state, and is provided with sixteen internal 16-bit general registers with a 32-bit configuration, and a concise and optimized instruction set. The CPU can handle a 16-Mbyte linear address space (architecturally 4 Gbytes). Programs based on the high-level language C can also be run efficiently.

Single-power-supply flash memory (F-ZTAT™*) and mask ROM versions are available, providing a quick and flexible response to conditions from ramp-up through full-scale volume production, even for applications with frequently changing specifications.

On-chip peripheral functions include a 16-bit free-running timer (FRT), 8-bit timer (TMR), watchdog timer (WDT), two PWM timers (PWM and PWMX), a serial communication interface (SCI, IrDA), host interface (HIF), D/A converter (DAC), A/D converter (ADC), and I/O ports. An I²C bus interface (IIC) can also be incorporated as an option.

An on-chip data transfer controller (DTC) is also provided, enabling high-speed data transfer without CPU intervention.

The H8S/2138 Group has all the above on-chip supporting functions, and can also be provided with an IIC module as an option. The H8S/2134 Group comprises reduced-function versions, with fewer TMR channels, and no PWM, HIF, IIC, or DTC modules.

Use of the H8S/2138 or H8S/2134 Group enables compact, high-performance systems to be implemented easily. The comprehensive PC-related interface functions and 16 × 8 matrix key-scan functions are ideal for applications such as notebook PC keyboard control and intelligent battery and power supply control, while the various timer functions and their interconnectability (timer connection), plus the interlinked operation of the I²C bus interface and data transfer controller (DTC), in particular, make these devices ideal for use in PC monitors. In addition, the combination of F-ZTAT™* and reduced-function versions is ideal for applications such as system units in which on-chip program memory is essential to meet performance requirements, product start-up times are short, and program modifications may be necessary after end-product assembly.

This manual describes the hardware of the H8S/2138 Group and H8S/2134 Group. Refer to the *H8S/2600 Series and H8S/2000 Series Software Manual* for a detailed description of the instruction set.

Note: * F-ZTAT (Flexible-ZTAT) is a trademark of Renesas Technology Corp.

On-Chip Supporting Modules

| Group | H8S/2138 Group | H8S/2134 Group |
|--------------------------------------|------------------------------|------------------------------|
| Product names | H8S/2138, 2137 | H8S/2134, 2133, 2132, 2130 |
| Bus controller (BSC) | Available (8 bits) | Available (8 bits) |
| Data transfer controller (DTC) | Available | — |
| 8-bit PWM timer (PWM) | ×16 | — |
| 14-bit PWM timer (PWMX) | ×2 | ×2 |
| 16-bit free-running timer (FRT) | ×1 | ×1 |
| 8-bit timer (TMR) | ×4 | ×3 |
| Timer connection | Available | — |
| Watchdog timer (WDT) | ×2 | ×2 |
| Serial communication interface (SCI) | ×3 | ×3 |
| I ² C bus interface (IIC) | ×2 (option) | — |
| Host interface (HIF) | ×2 | — |
| D/A converter | ×2 | ×2 |
| A/D converter | ×8 (analog input) | ×8 (analog input) |
| | ×8 (expansion A/D inputs) | ×8 (expansion A/D inputs) |

Main Revisions for This Edition

| Item | Page | Revision (See Manual for Details) | | | | | | | | | | | | | | | | | | | | | | | |
|---|-----------------------------|--|------------------------------|------------------------------|------|-------|------------------------------|--------------------|-------------------|------------------------------|----------------------|---|-------------------|-------------------|-----|---------|--------|-------------------|-------------------|--|----|-----------------------------|-----------------------------|-----------------------------|-----|
| All | — | <ul style="list-style-type: none"> Notification of change in company name amended (Before) Hitachi, Ltd. → (After) Renesas Technology Corp. Product naming convention amended (Before) H8S/2138 Series → (After) H8S/2138 Group (Before) H8S/2134 Series → (After) H8S/2134 Group <p>Description amended (Before) Serial/timer control register → (After) Serial timer control register</p> | | | | | | | | | | | | | | | | | | | | | | | |
| 1.3.2 Pin Functions in Each Operating Mode | 12 | Table amended | | | | | | | | | | | | | | | | | | | | | | | |
| Table 1.2 H8S/2138 Group Pin Functions in Each Operating Mode | | <table border="1"> <thead> <tr> <th rowspan="2">Pin No.</th> <th colspan="3">Pin Name</th> <th rowspan="2">Flash Memory Programmer Mode</th> </tr> <tr> <th>Expanded Modes</th> <th>Single-Chip Modes</th> <th>Flash Memory Programmer Mode</th> </tr> </thead> <tbody> <tr> <td>FP-80A</td> <td></td> <td>Mode 2 (EXPE = 1)</td> <td>Mode 2 (EXPE = 0)</td> <td></td> </tr> <tr> <td>TFP-80C</td> <td>Mode 1</td> <td>Mode 3 (EXPE = 1)</td> <td>Mode 3 (EXPE = 0)</td> <td></td> </tr> <tr> <td>28</td> <td>P67/TMOX/CIN7/ KIN7/IRQ7</td> <td>P67/TMOX/CIN7/ KIN7/IRQ7</td> <td>P67/TMOX/CIN7/ KIN7/IRQ7</td> <td>VSS</td> </tr> </tbody> </table> | Pin No. | Pin Name | | | Flash Memory Programmer Mode | Expanded Modes | Single-Chip Modes | Flash Memory Programmer Mode | FP-80A | | Mode 2 (EXPE = 1) | Mode 2 (EXPE = 0) | | TFP-80C | Mode 1 | Mode 3 (EXPE = 1) | Mode 3 (EXPE = 0) | | 28 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | VSS |
| Pin No. | Pin Name | | | Flash Memory Programmer Mode | | | | | | | | | | | | | | | | | | | | | |
| | Expanded Modes | Single-Chip Modes | Flash Memory Programmer Mode | | | | | | | | | | | | | | | | | | | | | | |
| FP-80A | | Mode 2 (EXPE = 1) | Mode 2 (EXPE = 0) | | | | | | | | | | | | | | | | | | | | | | |
| TFP-80C | Mode 1 | Mode 3 (EXPE = 1) | Mode 3 (EXPE = 0) | | | | | | | | | | | | | | | | | | | | | | |
| 28 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | VSS | | | | | | | | | | | | | | | | | | | | | |
| 2.6.1 Overview | 42 | Table amended | | | | | | | | | | | | | | | | | | | | | | | |
| Table 2.1 Instruction Classification | | <table border="1"> <thead> <tr> <th>Function</th> <th>Instructions</th> <th>Size</th> <th>Types</th> </tr> </thead> <tbody> <tr> <td rowspan="3">Arithmetic operations</td> <td>ADD, SUB, CMP, NEG</td> <td>BWL</td> <td>19</td> </tr> <tr> <td>ADDX, SUBX, DAA, DAS</td> <td>B</td> <td></td> </tr> <tr> <td>INC, DEC</td> <td>BWL</td> <td></td> </tr> </tbody> </table> | Function | Instructions | Size | Types | Arithmetic operations | ADD, SUB, CMP, NEG | BWL | 19 | ADDX, SUBX, DAA, DAS | B | | INC, DEC | BWL | | | | | | | | | | |
| Function | Instructions | Size | Types | | | | | | | | | | | | | | | | | | | | | | |
| Arithmetic operations | ADD, SUB, CMP, NEG | BWL | 19 | | | | | | | | | | | | | | | | | | | | | | |
| | ADDX, SUBX, DAA, DAS | B | | | | | | | | | | | | | | | | | | | | | | | |
| | INC, DEC | BWL | | | | | | | | | | | | | | | | | | | | | | | |

| Item | Page | Revision (See Manual for Details) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|--|-----------------------------------|-----------------------------------|--------------|---------------------------------|------|-----------------------------------|------|--|------|--|------|--|------|--|------|--|------|--|------|--|---|--|------|--|------|--|------|--|------|--|------|--|------|--|------|--|------|--|
| 9.3.1 Correspondence between PWM Data Register Contents and Output Waveform Table 9.4 Duty Cycle of Basic Pulse | 251 | Table amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Upper 4 Bits</th> <th>Basic Pulse Waveform (Internal)</th> </tr> </thead> <tbody> <tr> <td>0000</td> <td>0 1 2 3 4 5 6 7 8 9 A B C D E F 0</td> </tr> <tr> <td>0001</td> <td></td> </tr> <tr> <td>0010</td> <td></td> </tr> <tr> <td>0011</td> <td></td> </tr> <tr> <td>0100</td> <td></td> </tr> <tr> <td>0101</td> <td></td> </tr> <tr> <td>0110</td> <td></td> </tr> <tr> <td>0111</td> <td></td> </tr> <tr> <td>⋮</td> <td></td> </tr> <tr> <td>1000</td> <td></td> </tr> <tr> <td>1001</td> <td></td> </tr> <tr> <td>1010</td> <td></td> </tr> <tr> <td>1011</td> <td></td> </tr> <tr> <td>1100</td> <td></td> </tr> <tr> <td>1101</td> <td></td> </tr> <tr> <td>1110</td> <td></td> </tr> <tr> <td>1111</td> <td></td> </tr> </tbody> </table> | | | Upper 4 Bits | Basic Pulse Waveform (Internal) | 0000 | 0 1 2 3 4 5 6 7 8 9 A B C D E F 0 | 0001 | | 0010 | | 0011 | | 0100 | | 0101 | | 0110 | | 0111 | | ⋮ | | 1000 | | 1001 | | 1010 | | 1011 | | 1100 | | 1101 | | 1110 | | 1111 | |
| Upper 4 Bits | Basic Pulse Waveform (Internal) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0000 | 0 1 2 3 4 5 6 7 8 9 A B C D E F 0 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0001 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0010 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0011 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0100 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0101 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0110 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0111 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| ⋮ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1000 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1001 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1010 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1011 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1100 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1101 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1110 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1111 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

| | | |
|--------------------------|-----|-----------------|
| 10.1.3 Pin configuration | 255 | Channel deleted |
|--------------------------|-----|-----------------|

Table 10.1 Input and Output Pins

| | | |
|---------------|-----|---------------------|
| 12.1 Overview | 305 | Description amended |
|---------------|-----|---------------------|

The H8S/2138 Series also has two similar 8-bit timer channels (TMRX and TMR_Y). These channels can be used in a connected configuration using the timer connection function. TMRX and TMR_Y have greater input/output and interrupt function related restrictions than TMR0 and TMR1.

TMRX has a built-in H8S/2138, but does not have a built-in H8S/2134.

| Item | Page | Revision (See Manual for Details) |
|---|------------|--|
| 16.4 Usage Notes | 514 to 521 | <ul style="list-style-type: none"> Notes on WAIT Function Notes on ICDR Reads and ICCR Access in Slave Transmit Mode Notes on TRS Bit Setting in Slave Mode Notes on Notes on Arbitration Lost in Master Mode Notes on Interrupt Occurrence after ACKB Reception Description added |
| 17.1.3 Input and Output Pins | 525 | Note * amended |
| Table 17.1 Host Interface Input/Output Pins | | Note: * Selection of $\overline{CS2}$ or $\overline{ECS2}$ is by means of the CS2E bit in SYSCR and ... |
| 19.4.3 Input Sampling and A/D Conversion Time | 566 | Figure 19.5 amended |
| Figure 19.5 A/D Conversion Timing | | <p>The diagram shows the timing relationship between several signals during an A/D conversion. The clock signal ϕ is shown as a series of pulses, with the first pulse labeled (1). The address signal is shown as a pulse, with the second pulse labeled (2). The write signal is a single pulse. The input sampling timing is a long pulse that starts after the first clock pulse and ends before the ADF signal starts. The ADF signal is a pulse that starts after the input sampling timing ends. The time intervals are labeled as t_D (delay from clock to address), t_{SPL} (sampling period), and t_{CONV} (conversion time).</p> |
| 19.6 Usage Notes | 572 | Note added |
| Figure 19.11 Example of Analog Input Circuit | | Note: Values are reference values. |
| 21.5.2 Flash Memory Control Register 2 (FLMCR2) | 590 | Description amended |
| | | Bits 6 to 2—Reserved: Always write 0 when writing to these bits. |
| 21.6.1 Boot Mode | 597 | Description amended |
| | | ... H'(FF)E080 to H'(FF)EFFF (3968 bytes) in the 128-kbyte versions including H8S/2132, except for H8S/2132R or H'(FF)E880 to H'(FF)EFFF (1920 bytes) in the 64-kbyte versions including H8S/2132R, except for H8S/2132. |

| Item | Page | Revision (See Manual for Details) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|---|-------------|---|-------------------|-------------|--------------|-------------|-------------|------------------|------------------|----------|------------------|------------------|------------------------|-------------|-------------|-------------------|-------------|----------|-------------|----------|----------|----------|----------------------|-------------|-------------|-------------|-------------|----------|-------------|-------------|----------|----------------|
| 21.6.1 Boot Mode | 597 | Figure 21.10 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Figure 21.10 RAM Areas in Boot Mode | | Programming control ^{*1} program area (3,968 bytes) Boot program area ^{*2} (128 bytes) (a) 128-kbyte versions (including H8S/2132) (b) 64-kbyte versions (except for H8S/2132) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | Note 1 added | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | Note: 1. In H8S/2132 F-ZTAT (Mask ROM version), H'(FF)E080 to H'(FF)E87F is a reserved area that is used only for boot mode operation. Do not use this area for other purpose. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 598 | Description amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | · Before branching to the programming control program (RAM area H'(FF)E080 (128-kbyte versions including H8S/2132, except for H8S/2132R or H'(FF)E880 (64-kbyte versions, including H8S/2132R, except for H8S/2132)), ... | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 22.4.5 Register Configuration | 632 | Table 22.4 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 22.4 Flash Memory Registers | | (Before) \square ^{*3} → (After) R/W ^{*3} | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 23.7 Subclock Input Circuit | 678 | "Note on Subclock Usage" description added | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 24.1 Overview | 682 | Table 24.1 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 24.1 H8S/2138 Group and H8S/2134 Group Internal States in Each Mode | | <table border="1"> <thead> <tr> <th>Function</th> <th>High-Speed</th> <th>Medium-Speed</th> <th>Sleep</th> <th>Module Stop</th> <th>Watch</th> <th>Subactive</th> <th>Subsleep</th> <th>Software Standby</th> <th>Hardware Standby</th> </tr> </thead> <tbody> <tr> <td>On-chip supporting RAM</td> <td>Functioning</td> <td>Functioning</td> <td>Functioning (DTC)</td> <td>Functioning</td> <td>Retained</td> <td>Functioning</td> <td>Retained</td> <td>Retained</td> <td>Retained</td> </tr> <tr> <td>module operation I/O</td> <td>Functioning</td> <td>Functioning</td> <td>Functioning</td> <td>Functioning</td> <td>Retained</td> <td>Functioning</td> <td>Functioning</td> <td>Retained</td> <td>High impedance</td> </tr> </tbody> </table> | Function | High-Speed | Medium-Speed | Sleep | Module Stop | Watch | Subactive | Subsleep | Software Standby | Hardware Standby | On-chip supporting RAM | Functioning | Functioning | Functioning (DTC) | Functioning | Retained | Functioning | Retained | Retained | Retained | module operation I/O | Functioning | Functioning | Functioning | Functioning | Retained | Functioning | Functioning | Retained | High impedance |
| Function | High-Speed | Medium-Speed | Sleep | Module Stop | Watch | Subactive | Subsleep | Software Standby | Hardware Standby | | | | | | | | | | | | | | | | | | | | | | | |
| On-chip supporting RAM | Functioning | Functioning | Functioning (DTC) | Functioning | Retained | Functioning | Retained | Retained | Retained | | | | | | | | | | | | | | | | | | | | | | | |
| module operation I/O | Functioning | Functioning | Functioning | Functioning | Retained | Functioning | Functioning | Retained | High impedance | | | | | | | | | | | | | | | | | | | | | | | |
| 24.12 Usage Notes | 702 | Section 24.12 added | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 25.2.2 DC Characteristics | 709 | Note *4 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 25.3 DC Characteristics (1) | | Note: 4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138. ... P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 25.3 DC Characteristics (2) | 712 | Note *4 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | Note: 4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138. ... P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 25.3 DC Characteristics (3) | 715 | Note *4 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | Note: 4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138. ... P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

| Item | Page | Revision (See Manual for Details) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|---|--|--|----------------|--------|------|-----------------|--|------|-----------------|---------------------|--|----------|----------------|---|---|---|-----------------------|--|-----|---|---|---|--|--|------------------------|---|-----|---|--|---|---|--|-----|---|---|---|---|
| 25.2.7 Usage Note Figure 25.3 Connection of External Capacitor (Mask ROM Type Incorporating Step-Down Circuit and Product Not Incorporating Step-Down Circuit) | 732 | Description amended <Products incorporating internal step-down circuit> HD6432138S, HD6432138SW, HD6432137S, HD6432137SW, HD6432134S, HD6432133S, HD64F2138A, HD64F2134A | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 25.3.2 DC Characteristics Table 25.16 DC Characteristics (1) | 735 | Table 25.16 (1) amended <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> <th>Test Conditions</th> </tr> </thead> <tbody> <tr> <td rowspan="2">Output high voltage</td> <td rowspan="2">All output pins (except P97, and P52^{*4, *5})</td> <td>V_{OH}</td> <td>$V_{CC} - 0.5$</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -200 \mu A$</td> </tr> <tr> <td></td> <td>3.5</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -1 \text{ mA}$</td> </tr> <tr> <td></td> <td>P97, P52^{*4}</td> <td></td> <td>2.0</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -200 \mu A$, $V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$</td> </tr> </tbody> </table> | Item | Symbol | Min | Typ | Max | Unit | Test Conditions | Output high voltage | All output pins (except P97, and P52 ^{*4, *5}) | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$ | | P97, P52 ^{*4} | | 2.0 | — | — | V | $I_{OH} = -200 \mu A$, $V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$ | | | | | | |
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Output high voltage | All output pins (except P97, and P52 ^{*4, *5}) | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | P97, P52 ^{*4} | | 2.0 | — | — | V | $I_{OH} = -200 \mu A$, $V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 736 | Note *4 amended Note: 4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138. ... P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 25.16 DC Characteristics (2) | 738 | Table 25.16 (2) amended <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> <th>Test Conditions</th> </tr> </thead> <tbody> <tr> <td rowspan="3">Output high voltage</td> <td rowspan="3">All output pins (except P97, and P52^{*4, *5})</td> <td>V_{OH}</td> <td>$V_{CC} - 0.5$</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -200 \mu A$</td> </tr> <tr> <td></td> <td>3.5</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -1 \text{ mA}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$</td> </tr> <tr> <td></td> <td>3.0</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -1 \text{ mA}$, $V_{CC} < 4.5 \text{ V}$</td> </tr> <tr> <td></td> <td>P97, P52^{*4}</td> <td></td> <td>1.5</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -200 \mu A$, $V_{CC} = 4.0 \text{ to } 5.5 \text{ V}$</td> </tr> </tbody> </table> | Item | Symbol | Min | Typ | Max | Unit | Test Conditions | Output high voltage | All output pins (except P97, and P52 ^{*4, *5}) | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 3.0 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} < 4.5 \text{ V}$ | | P97, P52 ^{*4} | | 1.5 | — | — | V | $I_{OH} = -200 \mu A$, $V_{CC} = 4.0 \text{ to } 5.5 \text{ V}$ |
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Output high voltage | All output pins (except P97, and P52 ^{*4, *5}) | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | 3.0 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} < 4.5 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | P97, P52 ^{*4} | | 1.5 | — | — | V | $I_{OH} = -200 \mu A$, $V_{CC} = 4.0 \text{ to } 5.5 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 739 | Note *4 amended Note: 4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138. ... P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

| Item | Page | Revision (See Manual for Details) | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|---|------------------------|--|---------------------|--------|---------|---|-----|------|-----------------|---|------------|-------------------|---------------------|-----|---------|---|------------------------------------|----------|----------------|---|-----|---------|---|--|------------------------|-----|---|-----|---------|---|
| 25.3.2 DC Characteristics Table 25.16 DC Characteristics (3) | 740 | Table 25.16 (3) amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> <th>Test Conditions</th> </tr> </thead> <tbody> <tr> <td>Output high voltage</td> <td>V_{OH}</td> <td>$V_{CC} - 0.5$</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -200 \mu A$</td> </tr> <tr> <td></td> <td></td> <td>$V_{CC} - 1.0$</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -1 \text{ mA}$</td> </tr> <tr> <td></td> <td>P97, P52^{*4}</td> <td>0.5</td> <td>—</td> <td>—</td> <td>V</td> <td>$I_{OH} = -200 \mu A$ $V_{CC} = 2.7 \text{ to } 3.5 \text{ V}$</td> </tr> </tbody> </table> | Item | Symbol | Min | Typ | Max | Unit | Test Conditions | Output high voltage | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | | | $V_{CC} - 1.0$ | — | — | V | $I_{OH} = -1 \text{ mA}$ | | P97, P52 ^{*4} | 0.5 | — | — | V | $I_{OH} = -200 \mu A$ $V_{CC} = 2.7 \text{ to } 3.5 \text{ V}$ |
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | | | | | | | | | | | | | | | | | | | | | | | | |
| Output high voltage | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | | | | | | | | | | | | | | | | | | | | | | | | |
| | | $V_{CC} - 1.0$ | — | — | V | $I_{OH} = -1 \text{ mA}$ | | | | | | | | | | | | | | | | | | | | | | | | |
| | P97, P52 ^{*4} | 0.5 | — | — | V | $I_{OH} = -200 \mu A$ $V_{CC} = 2.7 \text{ to } 3.5 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | |
| | 742 | Note *4 amended Note: 4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138. ... P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138. | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 25.3.6 Flash Memory Characteristics Table 25.27 Flash Memory Characteristics (Programming/Erasing Operating Range) | 756 | Table 25.27 amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> <th>Test Condition</th> </tr> </thead> <tbody> <tr> <td>Reprogramming count</td> <td>N_{REC}</td> <td>100^{*8}</td> <td>10000^{*9}</td> <td>—</td> <td>Times</td> <td></td> </tr> <tr> <td>Data retention time^{*10}</td> <td>t_{DP}</td> <td>10</td> <td>—</td> <td>—</td> <td>Years</td> <td></td> </tr> </tbody> </table> | Item | Symbol | Min | Typ | Max | Unit | Test Condition | Reprogramming count | N_{REC} | 100 ^{*8} | 10000 ^{*9} | — | Times | | Data retention time ^{*10} | t_{DP} | 10 | — | — | Years | | | | | | | | |
| Item | Symbol | Min | Typ | Max | Unit | Test Condition | | | | | | | | | | | | | | | | | | | | | | | | |
| Reprogramming count | N_{REC} | 100 ^{*8} | 10000 ^{*9} | — | Times | | | | | | | | | | | | | | | | | | | | | | | | | |
| Data retention time ^{*10} | t_{DP} | 10 | — | — | Years | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 757 | Notes 8 to 10 added Notes: 8. Minimum number of times for which all characteristics are guaranteed after rewriting (Guarantee range is 1 to minimum value). 9. Reference value for 25C° (as a guide line, rewriting should normally function up to this value). 10. Data retention characteristics when rewriting is performed within the specification range, including the minimum value. | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 25.4.2 DC Characteristics Table 25.29 DC Characteristics (1) | 761 | Table 25.29 (1) amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> <th>Test Conditions</th> </tr> </thead> <tbody> <tr> <td>Three-state leakage current (off state)</td> <td>I_{IS}</td> <td>—</td> <td>—</td> <td>1.0</td> <td>μA</td> <td>$V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$</td> </tr> <tr> <td>Input pull-up MOS current</td> <td>$-I_p$</td> <td>50</td> <td>—</td> <td>300</td> <td>μA</td> <td>$V_{in} = 0 \text{ V}, V_{CC} = 5 \text{ V} \pm 10\%$</td> </tr> <tr> <td></td> <td></td> <td>60</td> <td>—</td> <td>500</td> <td>μA</td> <td></td> </tr> </tbody> </table> | Item | Symbol | Min | Typ | Max | Unit | Test Conditions | Three-state leakage current (off state) | $ I_{IS} $ | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ | Input pull-up MOS current | $-I_p$ | 50 | — | 300 | μA | $V_{in} = 0 \text{ V}, V_{CC} = 5 \text{ V} \pm 10\%$ | | | 60 | — | 500 | μA | |
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | | | | | | | | | | | | | | | | | | | | | | | | |
| Three-state leakage current (off state) | $ I_{IS} $ | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | |
| Input pull-up MOS current | $-I_p$ | 50 | — | 300 | μA | $V_{in} = 0 \text{ V}, V_{CC} = 5 \text{ V} \pm 10\%$ | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 60 | — | 500 | μA | | | | | | | | | | | | | | | | | | | | | | | | | |
| Table 25.29 DC Characteristics (3) | 766 | Note *5 added to test conditions for input pull-up MOS current $V_{in} = 0 \text{ V}, V_{CC} = 2.7 \text{ V}^{*5} \text{ to } 3.6 \text{ V}$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 25.5.2 DC Characteristics Table 25.40 DC Characteristics (1) | 782 | Table 25.40 (1) amended | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Item</th> <th>Symbol</th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> <th>Test Conditions</th> </tr> </thead> <tbody> <tr> <td>Input pull-up MOS current</td> <td>$-I_p$</td> <td>30</td> <td>—</td> <td>300</td> <td>μA</td> <td>$V_{in} = 0 \text{ V}, V_{CC} = 5 \text{ V} \pm 10\%$</td> </tr> <tr> <td></td> <td></td> <td>60</td> <td>—</td> <td>600</td> <td>μA</td> <td></td> </tr> </tbody> </table> | Item | Symbol | Min | Typ | Max | Unit | Test Conditions | Input pull-up MOS current | $-I_p$ | 30 | — | 300 | μA | $V_{in} = 0 \text{ V}, V_{CC} = 5 \text{ V} \pm 10\%$ | | | 60 | — | 600 | μA | | | | | | | | |
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | | | | | | | | | | | | | | | | | | | | | | | | |
| Input pull-up MOS current | $-I_p$ | 30 | — | 300 | μA | $V_{in} = 0 \text{ V}, V_{CC} = 5 \text{ V} \pm 10\%$ | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 60 | — | 600 | μA | | | | | | | | | | | | | | | | | | | | | | | | | |

Item **Page** **Revision (See Manual for Details)**

25.5.6 Flash Memory Characteristics 797 Table 25.49 amended

Table 25.49 Flash Memory Characteristics (Programming/Erasing Operating Range)

| Item | Symbol | Min | Typ | Max | Unit | Test Condition |
|------------------------------------|-----------|------|--------|-----|-------|----------------|
| Reprogramming count | N_{REC} | 100* | 10000* | — | Times | |
| Data retention time ^{#10} | t_{DRP} | 10 | — | — | Years | |

798 Notes 8 to 10 added

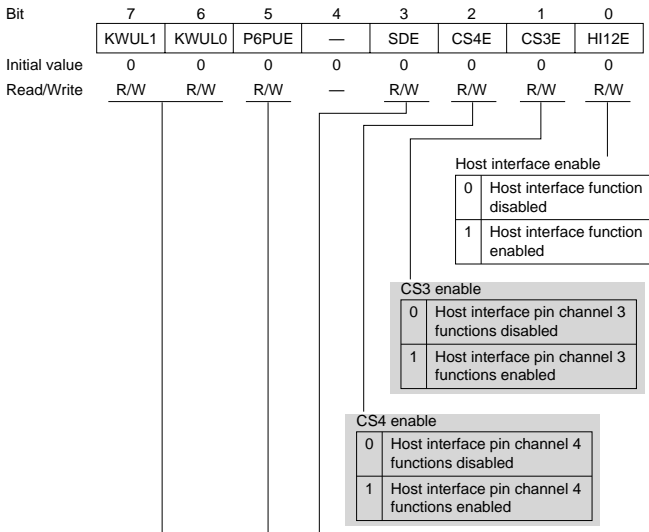
Notes: 8. Minimum number of times for which all characteristics are guaranteed after rewriting (Guarantee range is 1 to minimum value).

9. Reference value for 25C° (as a guide line, rewriting should normally function up to this value).

10. Data retention characteristics when rewriting is performed within the specification range, including the minimum value.

B.3 Function 906 SYSCR2 H'FF83 HIF

Figure amended



907 EBR1, 2 H'FF82, H'FF83 Flash memory

Note *2 amended

Note: 2. Bits EB8 and EB9 are not present in the 64-kbyte versions; these bits cannot be modified and are always read as 0.

Figure amended

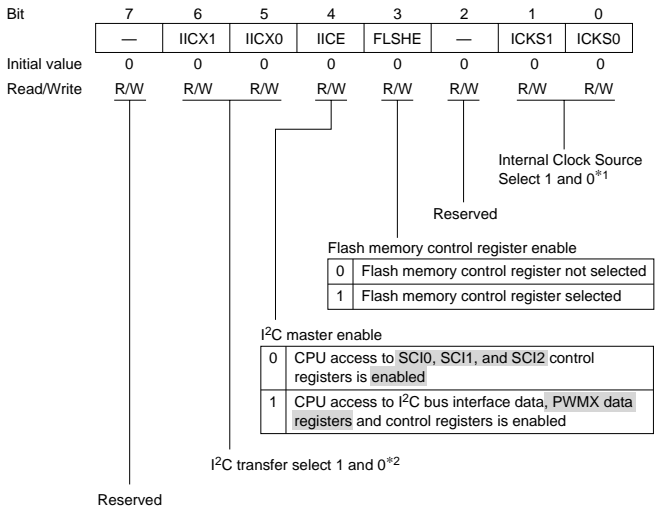


Figure amended

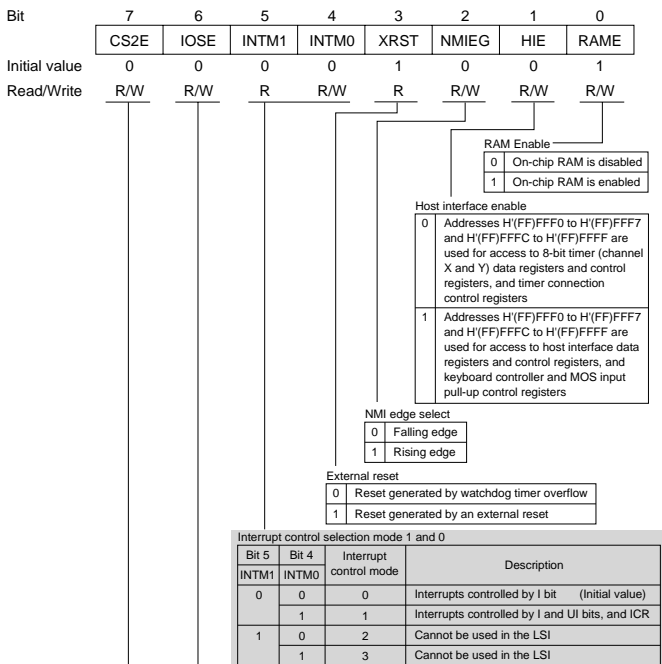


Figure amended

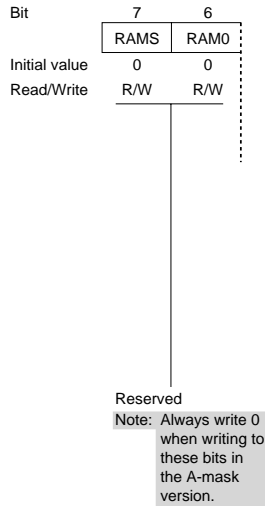
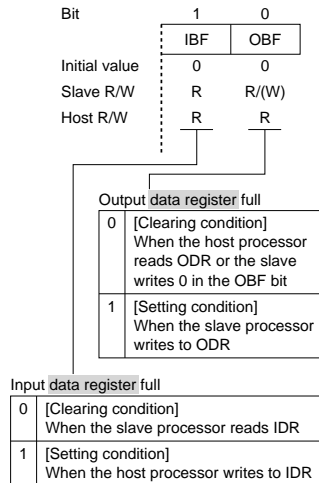


Figure amended



| Item | Page | Revision (See Manual for Details) |
|---|-------------|--|
| Appendix G Package Dimensions | 1002 | Figure replaced |
| Figure G.1 Package Dimensions (FP-80A) | | |
| Figure G.2 Package Dimensions (TFP-80C) | 1003 | Figure replaced |

Contents

| | | |
|-----------|--|----|
| Section 1 | Overview | 1 |
| 1.1 | Overview | 1 |
| 1.2 | Internal Block Diagram..... | 7 |
| 1.3 | Pin Arrangement and Functions..... | 9 |
| 1.3.1 | Pin Arrangement | 9 |
| 1.3.2 | Pin Functions in Each Operating Mode | 11 |
| 1.3.3 | Pin Functions | 18 |
| Section 2 | CPU | 25 |
| 2.1 | Overview..... | 25 |
| 2.1.1 | Features..... | 25 |
| 2.1.2 | Differences between H8S/2600 CPU and H8S/2000 CPU | 26 |
| 2.1.3 | Differences from H8/300 CPU | 27 |
| 2.1.4 | Differences from H8/300H CPU..... | 27 |
| 2.2 | CPU Operating Modes | 28 |
| 2.3 | Address Space..... | 33 |
| 2.4 | Register Configuration..... | 34 |
| 2.4.1 | Overview..... | 34 |
| 2.4.2 | General Registers | 35 |
| 2.4.3 | Control Registers | 36 |
| 2.4.4 | Initial Register Values..... | 38 |
| 2.5 | Data Formats..... | 39 |
| 2.5.1 | General Register Data Formats | 39 |
| 2.5.2 | Memory Data Formats | 41 |
| 2.6 | Instruction Set | 42 |
| 2.6.1 | Overview..... | 42 |
| 2.6.2 | Instructions and Addressing Modes | 43 |
| 2.6.3 | Table of Instructions Classified by Function | 44 |
| 2.6.4 | Basic Instruction Formats | 53 |
| 2.6.5 | Notes on Use of Bit-Manipulation Instructions | 54 |
| 2.7 | Addressing Modes and Effective Address Calculation | 55 |
| 2.7.1 | Addressing Mode | 55 |
| 2.7.2 | Effective Address Calculation | 58 |
| 2.8 | Processing States..... | 62 |
| 2.8.1 | Overview..... | 62 |
| 2.8.2 | Reset State..... | 63 |
| 2.8.3 | Exception-Handling State | 64 |
| 2.8.4 | Program Execution State..... | 65 |

| | | |
|--|---|-----------|
| 2.8.5 | Bus-Released State..... | 65 |
| 2.8.6 | Power-Down State | 65 |
| 2.9 | Basic Timing | 66 |
| 2.9.1 | Overview..... | 66 |
| 2.9.2 | On-Chip Memory (ROM, RAM)..... | 66 |
| 2.9.3 | On-Chip Supporting Module Access Timing | 68 |
| 2.9.4 | External Address Space Access Timing | 69 |
| 2.10 | Usage Note..... | 70 |
| 2.10.1 | TAS Instruction..... | 70 |
| 2.10.2 | STM/LDM Instruction | 70 |
| Section 3 MCU Operating Modes | | 71 |
| 3.1 | Overview..... | 71 |
| 3.1.1 | Operating Mode Selection | 71 |
| 3.1.2 | Register Configuration..... | 72 |
| 3.2 | Register Descriptions | 72 |
| 3.2.1 | Mode Control Register (MDCR) | 72 |
| 3.2.2 | System Control Register (SYSCR)..... | 73 |
| 3.2.3 | Bus Control Register (BCR) | 75 |
| 3.2.4 | Serial Timer Control Register (STCR) | 76 |
| 3.3 | Operating Mode Descriptions | 78 |
| 3.3.1 | Mode 1 | 78 |
| 3.3.2 | Mode 2 | 78 |
| 3.3.3 | Mode 3 | 78 |
| 3.4 | Pin Functions in Each Operating Mode | 79 |
| 3.5 | Memory Map in Each Operating Mode | 79 |
| Section 4 Exception Handling | | 91 |
| 4.1 | Overview..... | 91 |
| 4.1.1 | Exception Handling Types and Priority..... | 91 |
| 4.1.2 | Exception Handling Operation..... | 92 |
| 4.1.3 | Exception Sources and Vector Table | 92 |
| 4.2 | Reset..... | 94 |
| 4.2.1 | Overview..... | 94 |
| 4.2.2 | Reset Sequence | 94 |
| 4.2.3 | Interrupts after Reset..... | 96 |
| 4.3 | Interrupts..... | 97 |
| 4.4 | Trap Instruction..... | 98 |
| 4.5 | Stack Status after Exception Handling..... | 99 |
| 4.6 | Notes on Use of the Stack | 100 |

| | | |
|-----------|--|-----|
| Section 5 | Interrupt Controller | 101 |
| 5.1 | Overview..... | 101 |
| 5.1.1 | Features..... | 101 |
| 5.1.2 | Block Diagram..... | 102 |
| 5.1.3 | Pin Configuration..... | 102 |
| 5.1.4 | Register Configuration..... | 103 |
| 5.2 | Register Descriptions | 104 |
| 5.2.1 | System Control Register (SYSCR)..... | 104 |
| 5.2.2 | Interrupt Control Registers A to C (ICRA to ICRC)..... | 105 |
| 5.2.3 | IRQ Enable Register (IER) | 106 |
| 5.2.4 | IRQ Sense Control Registers H and L (ISCRH, ISCRL)..... | 106 |
| 5.2.5 | IRQ Status Register (ISR)..... | 107 |
| 5.2.6 | Keyboard Matrix Interrupt Mask Register (KMIMR) | 109 |
| 5.2.7 | Address Break Control Register (ABRKCR)..... | 111 |
| 5.2.8 | Break Address Registers A, B, C (BARA, BARB, BARC)..... | 112 |
| 5.3 | Interrupt Sources..... | 113 |
| 5.3.1 | External Interrupts | 113 |
| 5.3.2 | Internal Interrupts..... | 115 |
| 5.3.3 | Interrupt Exception Vector Table | 115 |
| 5.4 | Address Breaks | 118 |
| 5.4.1 | Features..... | 118 |
| 5.4.2 | Block Diagram..... | 118 |
| 5.4.3 | Operation | 119 |
| 5.4.4 | Usage Notes | 119 |
| 5.5 | Interrupt Operation..... | 121 |
| 5.5.1 | Interrupt Control Modes and Interrupt Operation..... | 121 |
| 5.5.2 | Interrupt Control Mode 0..... | 124 |
| 5.5.3 | Interrupt Control Mode 1 | 126 |
| 5.5.4 | Interrupt Exception Handling Sequence | 129 |
| 5.5.5 | Interrupt Response Times | 131 |
| 5.6 | Usage Notes | 132 |
| 5.6.1 | Contention between Interrupt Generation and Disabling..... | 132 |
| 5.6.2 | Instructions that Disable Interrupts | 133 |
| 5.6.3 | Interrupts during Execution of EEPMOV Instruction..... | 133 |
| 5.7 | DTC Activation by Interrupt..... | 134 |
| 5.7.1 | Overview..... | 134 |
| 5.7.2 | Block Diagram..... | 134 |
| 5.7.3 | Operation | 135 |
| Section 6 | Bus Controller | 137 |
| 6.1 | Overview..... | 137 |

| | | |
|---|---|------------|
| 6.1.1 | Features..... | 137 |
| 6.1.2 | Block Diagram..... | 138 |
| 6.1.3 | Pin Configuration..... | 139 |
| 6.1.4 | Register Configuration..... | 139 |
| 6.2 | Register Descriptions | 140 |
| 6.2.1 | Bus Control Register (BCR) | 140 |
| 6.2.2 | Wait State Control Register (WSCR) | 141 |
| 6.3 | Overview of Bus Control | 143 |
| 6.3.1 | Bus Specifications..... | 143 |
| 6.3.2 | Advanced Mode..... | 144 |
| 6.3.3 | Normal Mode..... | 144 |
| 6.3.4 | I/O Select Signal | 145 |
| 6.4 | Basic Bus Interface | 146 |
| 6.4.1 | Overview..... | 146 |
| 6.4.2 | Data Size and Data Alignment..... | 146 |
| 6.4.3 | Valid Strokes..... | 147 |
| 6.4.4 | Basic Timing..... | 148 |
| 6.4.5 | Wait Control | 151 |
| 6.5 | Burst ROM Interface..... | 153 |
| 6.5.1 | Overview..... | 153 |
| 6.5.2 | Basic Timing..... | 153 |
| 6.5.3 | Wait Control | 155 |
| 6.6 | Idle Cycle..... | 155 |
| 6.6.1 | Operation | 155 |
| 6.6.2 | Pin States in Idle Cycle | 156 |
| 6.7 | Bus Arbitration..... | 157 |
| 6.7.1 | Overview..... | 157 |
| 6.7.2 | Operation | 157 |
| 6.7.3 | Bus Transfer Timing..... | 158 |
| Section 7 Data Transfer Controller [H8S/2138 Group]..... | | 159 |
| 7.1 | Overview..... | 159 |
| 7.1.1 | Features..... | 159 |
| 7.1.2 | Block Diagram..... | 160 |
| 7.1.3 | Register Configuration..... | 161 |
| 7.2 | Register Descriptions | 162 |
| 7.2.1 | DTC Mode Register A (MRA) | 162 |
| 7.2.2 | DTC Mode Register B (MRB)..... | 164 |
| 7.2.3 | DTC Source Address Register (SAR)..... | 165 |
| 7.2.4 | DTC Destination Address Register (DAR)..... | 165 |
| 7.2.5 | DTC Transfer Count Register A (CRA) | 165 |

| | | |
|---------------------------|---|-----|
| 7.2.6 | DTC Transfer Count Register B (CRB)..... | 166 |
| 7.2.7 | DTC Enable Registers (DTCER)..... | 166 |
| 7.2.8 | DTC Vector Register (DTVECR)..... | 167 |
| 7.2.9 | Module Stop Control Register (MSTPCR)..... | 168 |
| 7.3 | Operation | 169 |
| 7.3.1 | Overview..... | 169 |
| 7.3.2 | Activation Sources | 171 |
| 7.3.3 | DTC Vector Table..... | 173 |
| 7.3.4 | Location of Register Information in Address Space | 175 |
| 7.3.5 | Normal Mode..... | 176 |
| 7.3.6 | Repeat Mode | 177 |
| 7.3.7 | Block Transfer Mode | 178 |
| 7.3.8 | Chain Transfer | 180 |
| 7.3.9 | Operation Timing..... | 181 |
| 7.3.10 | Number of DTC Execution States..... | 182 |
| 7.3.11 | Procedures for Using the DTC..... | 184 |
| 7.3.12 | Examples of Use of the DTC | 185 |
| 7.4 | Interrupts | 187 |
| 7.5 | Usage Notes | 187 |
| Section 8 I/O Ports | | 189 |
| 8.1 | Overview..... | 189 |
| 8.2 | Port 1 | 195 |
| 8.2.1 | Overview..... | 195 |
| 8.2.2 | Register Configuration..... | 197 |
| 8.2.3 | Pin Functions in Each Mode | 199 |
| 8.2.4 | MOS Input Pull-Up Function..... | 201 |
| 8.3 | Port 2..... | 201 |
| 8.3.1 | Overview..... | 201 |
| 8.3.2 | Register Configuration..... | 203 |
| 8.3.3 | Pin Functions in Each Mode | 205 |
| 8.3.4 | MOS Input Pull-Up Function..... | 207 |
| 8.4 | Port 3..... | 208 |
| 8.4.1 | Overview..... | 208 |
| 8.4.2 | Register Configuration..... | 209 |
| 8.4.3 | Pin Functions in Each Mode | 211 |
| 8.4.4 | MOS Input Pull-Up Function..... | 212 |
| 8.5 | Port 4..... | 213 |
| 8.5.1 | Overview..... | 213 |
| 8.5.2 | Register Configuration..... | 213 |
| 8.5.3 | Pin Functions | 214 |

| | | |
|--|---|-----|
| 8.6 | Port 5..... | 218 |
| 8.6.1 | Overview..... | 218 |
| 8.6.2 | Register Configuration..... | 218 |
| 8.6.3 | Pin Functions | 220 |
| 8.7 | Port 6..... | 221 |
| 8.7.1 | Overview..... | 221 |
| 8.7.2 | Register Configuration..... | 222 |
| 8.7.3 | Pin Functions | 225 |
| 8.7.4 | MOS Input Pull-Up Function..... | 227 |
| 8.8 | Port 7..... | 228 |
| 8.8.1 | Overview..... | 228 |
| 8.8.2 | Register Configuration..... | 228 |
| 8.8.3 | Pin Functions | 229 |
| 8.9 | Port 8..... | 230 |
| 8.9.1 | Overview..... | 230 |
| 8.9.2 | Register Configuration..... | 230 |
| 8.9.3 | Pin Functions | 231 |
| 8.10 | Port 9..... | 234 |
| 8.10.1 | Overview..... | 234 |
| 8.10.2 | Register Configuration..... | 235 |
| 8.10.3 | Pin Functions | 236 |
| Section 9 8-Bit PWM Timers [H8S/2138 Group]..... | | 241 |
| 9.1 | Overview..... | 241 |
| 9.1.1 | Features..... | 241 |
| 9.1.2 | Block Diagram..... | 242 |
| 9.1.3 | Pin Configuration..... | 243 |
| 9.1.4 | Register Configuration..... | 243 |
| 9.2 | Register Descriptions | 244 |
| 9.2.1 | PWM Register Select (PWSL)..... | 244 |
| 9.2.2 | PWM Data Registers (PWDR0 to PWDR15)..... | 246 |
| 9.2.3 | PWM Data Polarity Registers A and B (PWPRA and PWPBRB)..... | 246 |
| 9.2.4 | PWM Output Enable Registers A and B (PWOERA and PWOERB) | 247 |
| 9.2.5 | Peripheral Clock Select Register (PCSR) | 248 |
| 9.2.6 | Port 1 Data Direction Register (P1DDR)..... | 248 |
| 9.2.7 | Port 2 Data Direction Register (P2DDR)..... | 249 |
| 9.2.8 | Port 1 Data Register (P1DR)..... | 249 |
| 9.2.9 | Port 2 Data Register (P2DR)..... | 249 |
| 9.2.10 | Module Stop Control Register (MSTPCR)..... | 250 |
| 9.3 | Operation | 251 |

| | | |
|-------------------|---|------------|
| 9.3.1 | Correspondence between PWM Data Register Contents and Output Waveform..... | 251 |
| Section 10 | 14-Bit PWM D/A | 253 |
| 10.1 | Overview..... | 253 |
| 10.1.1 | Features..... | 253 |
| 10.1.2 | Block Diagram..... | 254 |
| 10.1.3 | Pin Configuration..... | 255 |
| 10.1.4 | Register Configuration..... | 255 |
| 10.2 | Register Descriptions | 256 |
| 10.2.1 | PWM D/A Counter (DACNT)..... | 256 |
| 10.2.2 | D/A Data Registers A and B (DADRA and DADRB)..... | 257 |
| 10.2.3 | PWM D/A Control Register (DACR)..... | 259 |
| 10.2.4 | Module Stop Control Register (MSTPCR)..... | 261 |
| 10.3 | Bus Master Interface | 262 |
| 10.4 | Operation | 265 |
| Section 11 | 16-Bit Free-Running Timer..... | 269 |
| 11.1 | Overview..... | 269 |
| 11.1.1 | Features..... | 269 |
| 11.1.2 | Block Diagram..... | 270 |
| 11.1.3 | Input and Output Pins | 271 |
| 11.1.4 | Register Configuration..... | 272 |
| 11.2 | Register Descriptions | 273 |
| 11.2.1 | Free-Running Counter (FRC) | 273 |
| 11.2.2 | Output Compare Registers A and B (OCRA, OCRB) | 273 |
| 11.2.3 | Input Capture Registers A to D (ICRA to ICRD)..... | 274 |
| 11.2.4 | Output Compare Registers AR and AF (OCRAR, OCRAF) | 275 |
| 11.2.5 | Output Compare Register DM (OCRDM)..... | 276 |
| 11.2.6 | Timer Interrupt Enable Register (TIER)..... | 276 |
| 11.2.7 | Timer Control/Status Register (TCSR)..... | 278 |
| 11.2.8 | Timer Control Register (TCR)..... | 282 |
| 11.2.9 | Timer Output Compare Control Register (TOCR) | 284 |
| 11.2.10 | Module Stop Control Register (MSTPCR)..... | 286 |
| 11.3 | Operation | 287 |
| 11.3.1 | FRC Increment Timing..... | 287 |
| 11.3.2 | Output Compare Output Timing..... | 288 |
| 11.3.3 | FRC Clear Timing..... | 289 |
| 11.3.4 | Input Capture Input Timing | 289 |
| 11.3.5 | Timing of Input Capture Flag (ICF) Setting | 292 |
| 11.3.6 | Setting of Output Compare Flags A and B (OCFA, OCFB)..... | 293 |

| | | |
|------------|---|-----|
| 11.3.7 | Setting of FRC Overflow Flag (OVF) | 294 |
| 11.3.8 | Automatic Addition of OCRA and OCRAR/OCRAF | 294 |
| 11.3.9 | ICRD and OCRDM Mask Signal Generation | 295 |
| 11.4 | Interrupts | 296 |
| 11.5 | Sample Application | 297 |
| 11.6 | Usage Notes | 298 |
| | | |
| Section 12 | 8-Bit Timers | 305 |
| 12.1 | Overview | 305 |
| 12.1.1 | Features | 305 |
| 12.1.2 | Block Diagram | 306 |
| 12.1.3 | Pin Configuration | 307 |
| 12.1.4 | Register Configuration | 308 |
| 12.2 | Register Descriptions | 309 |
| 12.2.1 | Timer Counter (TCNT) | 309 |
| 12.2.2 | Time Constant Register A (TCORA) | 310 |
| 12.2.3 | Time Constant Register B (TCORB) | 311 |
| 12.2.4 | Timer Control Register (TCR) | 312 |
| 12.2.5 | Timer Control/Status Register (TCSR) | 315 |
| 12.2.6 | Serial Timer Control Register (STCR) | 319 |
| 12.2.7 | System Control Register (SYSCR) | 320 |
| 12.2.8 | Timer Connection Register S (TCONRS) | 320 |
| 12.2.9 | Input Capture Register (TICR) [TMRX Additional Function] | 321 |
| 12.2.10 | Time Constant Register C (TCORC) [TMRX Additional Function] | 322 |
| 12.2.11 | Input Capture Registers R and F (TICRR, TICRF) [TMRX Additional Functions] | 322 |
| 12.2.12 | Timer Input Select Register (TISR) [TMRY Additional Function] | 323 |
| 12.2.13 | Module Stop Control Register (MSTPCR) | 324 |
| 12.3 | Operation | 325 |
| 12.3.1 | TCNT Incrementation Timing | 325 |
| 12.3.2 | Compare-Match Timing | 326 |
| 12.3.3 | TCNT External Reset Timing | 328 |
| 12.3.4 | Timing of Overflow Flag (OVF) Setting | 328 |
| 12.3.5 | Operation with Cascaded Connection | 329 |
| 12.3.6 | Input Capture Operation | 330 |
| 12.4 | Interrupt Sources | 333 |
| 12.5 | 8-Bit Timer Application Example | 334 |
| 12.6 | Usage Notes | 335 |
| 12.6.1 | Contention between TCNT Write and Clear | 335 |
| 12.6.2 | Contention between TCNT Write and Increment | 336 |
| 12.6.3 | Contention between TCOR Write and Compare-Match | 337 |

| | | |
|--|---|------------|
| 12.6.4 | Contention between Compare-Matches A and B..... | 338 |
| 12.6.5 | Switching of Internal Clocks and TCNT Operation..... | 338 |
| Section 13 Timer Connection [H8S/2138 Group]..... | | 341 |
| 13.1 | Overview..... | 341 |
| 13.1.1 | Features..... | 341 |
| 13.1.2 | Block Diagram..... | 342 |
| 13.1.3 | Input and Output Pins | 343 |
| 13.1.4 | Register Configuration..... | 344 |
| 13.2 | Register Descriptions | 344 |
| 13.2.1 | Timer Connection Register I (TCONRI) | 344 |
| 13.2.2 | Timer Connection Register O (TCONRO) | 347 |
| 13.2.3 | Timer Connection Register S (TCONRS)..... | 349 |
| 13.2.4 | Edge Sense Register (SEDGR) | 351 |
| 13.2.5 | Module Stop Control Register (MSTPCR)..... | 354 |
| 13.3 | Operation | 355 |
| 13.3.1 | PWM Decoding (PDC Signal Generation) | 355 |
| 13.3.2 | Clamp Waveform Generation (CL1/CL2/CL3 Signal Generation) | 357 |
| 13.3.3 | Measurement of 8-Bit Timer Divided Waveform Period | 358 |
| 13.3.4 | IHI Signal and 2fH Modification | 360 |
| 13.3.5 | IVI Signal Fall Modification and IHI Synchronization | 362 |
| 13.3.6 | Internal Synchronization Signal Generation (IHG/IVG/CL4 Signal Generation) | 364 |
| 13.3.7 | HSYNCO Output | 367 |
| 13.3.8 | VSYNCO Output | 368 |
| 13.3.9 | CBLANK Output | 369 |
| Section 14 Watchdog Timer (WDT)..... | | 371 |
| 14.1 | Overview..... | 371 |
| 14.1.1 | Features..... | 371 |
| 14.1.2 | Block Diagram..... | 372 |
| 14.1.3 | Pin Configuration..... | 374 |
| 14.1.4 | Register Configuration..... | 374 |
| 14.2 | Register Descriptions | 375 |
| 14.2.1 | Timer Counter (TCNT)..... | 375 |
| 14.2.2 | Timer Control/Status Register (TCSR) | 376 |
| 14.2.3 | System Control Register (SYSCR) | 379 |
| 14.2.4 | Notes on Register Access..... | 380 |
| 14.3 | Operation | 381 |
| 14.3.1 | Watchdog Timer Operation | 381 |
| 14.3.2 | Interval Timer Operation | 382 |

| | | |
|---|--|------------|
| 14.3.3 | Timing of Setting of Overflow Flag (OVF)..... | 383 |
| 14.4 | Interrupts..... | 384 |
| 14.5 | Usage Notes..... | 384 |
| 14.5.1 | Contention between Timer Counter (TCNT) Write and Increment..... | 384 |
| 14.5.2 | Changing Value of CKS2 to CKS0..... | 385 |
| 14.5.3 | Switching between Watchdog Timer Mode and Interval Timer Mode..... | 385 |
| 14.5.4 | Counter Value in Transitions between High-Speed Mode, Subactive Mode, and Watch Mode..... | 385 |
| 14.5.5 | OVF Flag Clear Condition..... | 386 |
| Section 15 Serial Communication Interface (SCI, IrDA)..... | | 387 |
| 15.1 | Overview..... | 387 |
| 15.1.1 | Features..... | 387 |
| 15.1.2 | Block Diagram..... | 389 |
| 15.1.3 | Pin Configuration..... | 390 |
| 15.1.4 | Register Configuration..... | 390 |
| 15.2 | Register Descriptions..... | 392 |
| 15.2.1 | Receive Shift Register (RSR)..... | 392 |
| 15.2.2 | Receive Data Register (RDR)..... | 392 |
| 15.2.3 | Transmit Shift Register (TSR)..... | 393 |
| 15.2.4 | Transmit Data Register (TDR)..... | 393 |
| 15.2.5 | Serial Mode Register (SMR)..... | 394 |
| 15.2.6 | Serial Control Register (SCR)..... | 397 |
| 15.2.7 | Serial Status Register (SSR)..... | 401 |
| 15.2.8 | Bit Rate Register (BRR)..... | 405 |
| 15.2.9 | Serial Interface Mode Register (SCMR)..... | 413 |
| 15.2.10 | Module Stop Control Register (MSTPCR)..... | 414 |
| 15.2.11 | Keyboard Comparator Control Register (KBCOMP)..... | 416 |
| 15.3 | Operation..... | 417 |
| 15.3.1 | Overview..... | 417 |
| 15.3.2 | Operation in Asynchronous Mode..... | 419 |
| 15.3.3 | Multiprocessor Communication Function..... | 430 |
| 15.3.4 | Operation in Synchronous Mode..... | 438 |
| 15.3.5 | IrDA Operation..... | 447 |
| 15.4 | SCI Interrupts..... | 450 |
| 15.5 | Usage Notes..... | 451 |
| Section 16 I²C Bus Interface [H8S/2138 Group Option]..... | | 455 |
| 16.1 | Overview..... | 455 |
| 16.1.1 | Features..... | 455 |
| 16.1.2 | Block Diagram..... | 456 |

| | | |
|--|---|-----|
| 16.1.3 | Input/Output Pins | 458 |
| 16.1.4 | Register Configuration..... | 459 |
| 16.2 | Register Descriptions | 460 |
| 16.2.1 | I ² C Bus Data Register (ICDR) | 460 |
| 16.2.2 | Slave Address Register (SAR)..... | 463 |
| 16.2.3 | Second Slave Address Register (SARX) | 464 |
| 16.2.4 | I ² C Bus Mode Register (ICMR)..... | 465 |
| 16.2.5 | I ² C Bus Control Register (ICCR)..... | 468 |
| 16.2.6 | I ² C Bus Status Register (ICSR)..... | 475 |
| 16.2.7 | Serial Timer Control Register (STCR) | 480 |
| 16.2.8 | DDC Switch Register (DDCSWR) | 481 |
| 16.2.9 | Module Stop Control Register (MSTPCR)..... | 484 |
| 16.3 | Operation | 485 |
| 16.3.1 | I ² C Bus Data Format | 485 |
| 16.3.2 | Master Transmit Operation | 487 |
| 16.3.3 | Master Receive Operation..... | 489 |
| 16.3.4 | Slave Receive Operation..... | 492 |
| 16.3.5 | Slave Transmit Operation | 495 |
| 16.3.6 | IRIC Setting Timing and SCL Control | 496 |
| 16.3.7 | Automatic Switching from Formatless Mode to I ² C Bus Format | 498 |
| 16.3.8 | Operation Using the DTC | 499 |
| 16.3.9 | Noise Canceler | 500 |
| 16.3.10 | Sample Flowcharts..... | 500 |
| 16.3.11 | Initialization of Internal State | 505 |
| 16.4 | Usage Notes | 506 |
| Section 17 Host Interface [H8S/2138 Group] | | 523 |
| 17.1 | Overview..... | 523 |
| 17.1.1 | Features..... | 523 |
| 17.1.2 | Block Diagram..... | 524 |
| 17.1.3 | Input and Output Pins | 525 |
| 17.1.4 | Register Configuration..... | 526 |
| 17.2 | Register Descriptions | 527 |
| 17.2.1 | System Control Register (SYSCR) | 527 |
| 17.2.2 | System Control Register 2 (SYSCR2)..... | 528 |
| 17.2.3 | Host Interface Control Register (HICR) | 529 |
| 17.2.4 | Input Data Register 1 (IDR1)..... | 530 |
| 17.2.5 | Output Data Register 1 (ODR1)..... | 530 |
| 17.2.6 | Status Register 1 (STR1) | 531 |
| 17.2.7 | Input Data Register 2 (IDR2)..... | 532 |
| 17.2.8 | Output Data Register 2 (ODR2)..... | 533 |

| | | |
|---------------------------------|---|------------|
| 17.2.9 | Status Register 2 (STR2) | 533 |
| 17.2.10 | Module Stop Control Register (MSTPCR) | 535 |
| 17.3 | Operation | 536 |
| 17.3.1 | Host Interface Operation | 536 |
| 17.3.2 | Control States | 536 |
| 17.3.3 | A20 Gate | 537 |
| 17.3.4 | Host Interface Pin Shutdown Function | 539 |
| 17.4 | Interrupts | 541 |
| 17.4.1 | IBF1, IBF2 | 541 |
| 17.4.2 | HIRQ11, HIRQ1, and HIRQ12 | 541 |
| 17.5 | Usage Note | 542 |
| Section 18 D/A Converter | | 543 |
| 18.1 | Overview | 543 |
| 18.1.1 | Features | 543 |
| 18.1.2 | Block Diagram | 544 |
| 18.1.3 | Input and Output Pins | 545 |
| 18.1.4 | Register Configuration | 545 |
| 18.2 | Register Descriptions | 546 |
| 18.2.1 | D/A Data Registers 0 and 1 (DADR0, DADR1) | 546 |
| 18.2.2 | D/A Control Register (DACR) | 546 |
| 18.2.3 | Module Stop Control Register (MSTPCR) | 548 |
| 18.3 | Operation | 549 |
| Section 19 A/D Converter | | 551 |
| 19.1 | Overview | 551 |
| 19.1.1 | Features | 551 |
| 19.1.2 | Block Diagram | 552 |
| 19.1.3 | Pin Configuration | 553 |
| 19.1.4 | Register Configuration | 554 |
| 19.2 | Register Descriptions | 555 |
| 19.2.1 | A/D Data Registers A to D (ADDRA to ADDRD) | 555 |
| 19.2.2 | A/D Control/Status Register (ADCSR) | 556 |
| 19.2.3 | A/D Control Register (ADCR) | 558 |
| 19.2.4 | Keyboard Comparator Control Register (KBCOMP) | 559 |
| 19.2.5 | Module Stop Control Register (MSTPCR) | 560 |
| 19.3 | Interface to Bus Master | 561 |
| 19.4 | Operation | 562 |
| 19.4.1 | Single Mode (SCAN = 0) | 562 |
| 19.4.2 | Scan Mode (SCAN = 1) | 564 |
| 19.4.3 | Input Sampling and A/D Conversion Time | 565 |

| | | |
|---|--|-----|
| 19.4.4 | External Trigger Input Timing | 567 |
| 19.5 | Interrupts | 567 |
| 19.6 | Usage Notes | 568 |
| Section 20 RAM | | 573 |
| 20.1 | Overview | 573 |
| 20.1.1 | Block Diagram | 573 |
| 20.1.2 | Register Configuration | 574 |
| 20.2 | System Control Register (SYSCR) | 574 |
| 20.3 | Operation | 575 |
| 20.3.1 | Expanded Mode (Modes 1, 2, and 3 (EXPE = 1)) | 575 |
| 20.3.2 | Single-Chip Mode (Modes 2 and 3 (EXPE = 0)) | 575 |
| Section 21 ROM (Mask ROM Version, H8S/2138 F-ZTAT, H8S/2134 F-ZTAT, and H8S/2132 F-ZTAT) | | 577 |
| 21.1 | Overview | 577 |
| 21.1.1 | Block Diagram | 577 |
| 21.1.2 | Register Configuration | 578 |
| 21.2 | Register Descriptions | 578 |
| 21.2.1 | Mode Control Register (MDCR) | 578 |
| 21.3 | Operation | 579 |
| 21.4 | Overview of Flash Memory | 580 |
| 21.4.1 | Features | 580 |
| 21.4.2 | Block Diagram | 581 |
| 21.4.3 | Flash Memory Operating Modes | 582 |
| 21.4.4 | Pin Configuration | 586 |
| 21.4.5 | Register Configuration | 586 |
| 21.5 | Register Descriptions | 587 |
| 21.5.1 | Flash Memory Control Register 1 (FLMCR1) | 587 |
| 21.5.2 | Flash Memory Control Register 2 (FLMCR2) | 589 |
| 21.5.3 | Erase Block Registers 1 and 2 (EBR1, EBR2) | 591 |
| 21.5.4 | Serial Timer Control Register (STCR) | 592 |
| 21.6 | On-Board Programming Modes | 593 |
| 21.6.1 | Boot Mode | 594 |
| 21.6.2 | User Program Mode | 599 |
| 21.7 | Programming/Erasing Flash Memory | 600 |
| 21.7.1 | Program Mode | 600 |
| 21.7.2 | Program-Verify Mode | 601 |
| 21.7.3 | Erase Mode | 603 |
| 21.7.4 | Erase-Verify Mode | 603 |
| 21.8 | Flash Memory Protection | 605 |

| | | |
|------------|--|-----|
| 21.8.1 | Hardware Protection | 605 |
| 21.8.2 | Software Protection..... | 605 |
| 21.8.3 | Error Protection..... | 606 |
| 21.9 | Interrupt Handling when Programming/Erasing Flash Memory | 608 |
| 21.10 | Flash Memory Programmer Mode | 609 |
| 21.10.1 | Programmer Mode Setting | 609 |
| 21.10.2 | Socket Adapters and Memory Map | 610 |
| 21.10.3 | Programmer Mode Operation | 610 |
| 21.10.4 | Memory Read Mode | 611 |
| 21.10.5 | Auto-Program Mode | 615 |
| 21.10.6 | Auto-Erase Mode..... | 617 |
| 21.10.7 | Status Read Mode | 618 |
| 21.10.8 | Status Polling | 620 |
| 21.10.9 | Programmer Mode Transition Time | 620 |
| 21.10.10 | Notes on Memory Programming..... | 621 |
| 21.11 | Flash Memory Programming and Erasing Precautions | 621 |
| 21.12 | Note on Switching from F-ZTAT Version to Mask ROM Version | 622 |
| | | |
| Section 22 | ROM (H8S/2138 F-ZTAT A-Mask Version, H8S/2134 F-ZTAT A-Mask Version)..... | 623 |
| 22.1 | Overview..... | 623 |
| 22.1.1 | Block Diagram..... | 623 |
| 22.1.2 | Register Configuration..... | 624 |
| 22.2 | Register Descriptions | 624 |
| 22.2.1 | Mode Control Register (MDCR) | 624 |
| 22.3 | Operation | 625 |
| 22.4 | Overview of Flash Memory | 626 |
| 22.4.1 | Features..... | 626 |
| 22.4.2 | Block Diagram..... | 627 |
| 22.4.3 | Flash Memory Operating Modes | 628 |
| 22.4.4 | Pin Configuration..... | 632 |
| 22.4.5 | Register Configuration..... | 632 |
| 22.5 | Register Descriptions | 633 |
| 22.5.1 | Flash Memory Control Register 1 (FLMCR1)..... | 633 |
| 22.5.2 | Flash Memory Control Register 2 (FLMCR2)..... | 635 |
| 22.5.3 | Erase Block Registers 1 and 2 (EBR1, EBR2)..... | 637 |
| 22.5.4 | Serial Timer Control Register (STCR) | 638 |
| 22.6 | On-Board Programming Modes..... | 639 |
| 22.6.1 | Boot Mode | 640 |
| 22.6.2 | User Program Mode..... | 645 |
| 22.7 | Programming/Erasing Flash Memory | 646 |

| | | |
|---|---|------------|
| 22.7.1 | Program Mode | 646 |
| 22.7.2 | Program-Verify Mode..... | 647 |
| 22.7.3 | Erase Mode | 649 |
| 22.7.4 | Erase-Verify Mode | 649 |
| 22.8 | Flash Memory Protection..... | 651 |
| 22.8.1 | Hardware Protection | 651 |
| 22.8.2 | Software Protection..... | 651 |
| 22.8.3 | Error Protection..... | 652 |
| 22.9 | Interrupt Handling when Programming/Erasing Flash Memory | 654 |
| 22.10 | Flash Memory Programmer Mode | 655 |
| 22.10.1 | Programmer Mode Setting | 655 |
| 22.10.2 | Socket Adapters and Memory Map | 656 |
| 22.10.3 | Programmer Mode Operation | 656 |
| 22.10.4 | Memory Read Mode | 657 |
| 22.10.5 | Auto-Program Mode | 661 |
| 22.10.6 | Auto-Erase Mode | 663 |
| 22.10.7 | Status Read Mode | 664 |
| 22.10.8 | Status Polling | 666 |
| 22.10.9 | Programmer Mode Transition Time | 666 |
| 22.10.10 | Notes on Memory Programming..... | 667 |
| 22.11 | Flash Memory Programming and Erasing Precautions..... | 667 |
| 22.12 | Note on Switching from F-ZTAT Version to Mask ROM Version | 668 |
| Section 23 Clock Pulse Generator | | 669 |
| 23.1 | Overview..... | 669 |
| 23.1.1 | Block Diagram..... | 669 |
| 23.1.2 | Register Configuration..... | 670 |
| 23.2 | Register Descriptions | 670 |
| 23.2.1 | Standby Control Register (SBYCR) | 670 |
| 23.2.2 | Low-Power Control Register (LPWRCR) | 671 |
| 23.3 | Oscillator..... | 672 |
| 23.3.1 | Connecting a Crystal Resonator..... | 672 |
| 23.3.2 | External Clock Input..... | 674 |
| 23.4 | Duty Adjustment Circuit..... | 677 |
| 23.5 | Medium-Speed Clock Divider | 677 |
| 23.6 | Bus Master Clock Selection Circuit..... | 677 |
| 23.7 | Subclock Input Circuit | 677 |
| 23.8 | Subclock Waveform Shaping Circuit..... | 678 |
| 23.9 | Clock Selection Circuit | 679 |

| | | |
|------------|--|-----|
| Section 24 | Power-Down State | 681 |
| 24.1 | Overview..... | 681 |
| 24.1.1 | Register Configuration..... | 685 |
| 24.2 | Register Descriptions | 685 |
| 24.2.1 | Standby Control Register (SBYCR) | 685 |
| 24.2.2 | Low-Power Control Register (LPWRCR) | 687 |
| 24.2.3 | Timer Control/Status Register (TCSR)..... | 689 |
| 24.2.4 | Module Stop Control Register (MSTPCR) | 690 |
| 24.3 | Medium-Speed Mode..... | 691 |
| 24.4 | Sleep Mode | 692 |
| 24.4.1 | Sleep Mode | 692 |
| 24.4.2 | Clearing Sleep Mode..... | 692 |
| 24.5 | Module Stop Mode | 693 |
| 24.5.1 | Module Stop Mode | 693 |
| 24.5.2 | Usage Note..... | 694 |
| 24.6 | Software Standby Mode..... | 695 |
| 24.6.1 | Software Standby Mode..... | 695 |
| 24.6.2 | Clearing Software Standby Mode | 695 |
| 24.6.3 | Setting Oscillation Settling Time after Clearing Software Standby Mode | 696 |
| 24.6.4 | Software Standby Mode Application Example..... | 696 |
| 24.6.5 | Usage Note..... | 697 |
| 24.7 | Hardware Standby Mode | 697 |
| 24.7.1 | Hardware Standby Mode | 697 |
| 24.7.2 | Hardware Standby Mode Timing..... | 698 |
| 24.8 | Watch Mode..... | 699 |
| 24.8.1 | Watch Mode..... | 699 |
| 24.8.2 | Clearing Watch Mode | 699 |
| 24.9 | Subsleep Mode..... | 700 |
| 24.9.1 | Subsleep Mode..... | 700 |
| 24.9.2 | Clearing Subsleep Mode | 700 |
| 24.10 | Subactive Mode | 701 |
| 24.10.1 | Subactive Mode | 701 |
| 24.10.2 | Clearing Subactive Mode..... | 701 |
| 24.11 | Direct Transition | 702 |
| 24.11.1 | Overview of Direct Transition | 702 |
| 24.12 | Usage Notes | 702 |
| Section 25 | Electrical Characteristics..... | 703 |
| 25.1 | Voltage of Power Supply and Operating Range | 703 |
| 25.2 | Electrical Characteristics of H8S/2138 F-ZTAT..... | 706 |
| 25.2.1 | Absolute Maximum Ratings | 706 |

| | | |
|----------------------------------|---|-----|
| 25.2.2 | DC Characteristics | 707 |
| 25.2.3 | AC Characteristics | 718 |
| 25.2.4 | A/D Conversion Characteristics..... | 727 |
| 25.2.5 | D/A Conversion Characteristics..... | 729 |
| 25.2.6 | Flash Memory Characteristics | 730 |
| 25.2.7 | Usage Note..... | 731 |
| 25.3 | Electrical Characteristics of H8S/2138 F-ZTAT (A-Mask Version), and Mask ROM Versions of H8S/2138 and H8S/2137 | 733 |
| 25.3.1 | Absolute Maximum Ratings | 733 |
| 25.3.2 | DC Characteristics | 734 |
| 25.3.3 | AC Characteristics | 744 |
| 25.3.4 | A/D Conversion Characteristics..... | 753 |
| 25.3.5 | D/A Conversion Characteristics..... | 755 |
| 25.3.6 | Flash Memory Characteristics | 756 |
| 25.3.7 | Usage Note..... | 758 |
| 25.4 | Electrical Characteristics of H8S/2134 F-ZTAT, H8S/2132 F-ZTAT, and Mask ROM Versions of H8S/2132 and H8S/2130 | 759 |
| 25.4.1 | Absolute Maximum Ratings | 759 |
| 25.4.2 | DC Characteristics | 760 |
| 25.4.3 | AC Characteristics | 768 |
| 25.4.4 | A/D Conversion Characteristics..... | 775 |
| 25.4.5 | D/A Conversion Characteristics..... | 777 |
| 25.4.6 | Flash Memory Characteristics | 778 |
| 25.4.7 | Usage Note..... | 779 |
| 25.5 | Electrical Characteristics of H8S/2134 F-ZTAT (A-Mask Version), and Mask ROM Versions of H8S/2134 and H8S/2133 | 780 |
| 25.5.1 | Absolute Maximum Ratings | 780 |
| 25.5.2 | DC Characteristics | 781 |
| 25.5.3 | AC Characteristics | 787 |
| 25.5.4 | A/D Conversion Characteristics..... | 794 |
| 25.5.5 | D/A Conversion Characteristics..... | 796 |
| 25.5.6 | Flash Memory Characteristics | 797 |
| 25.5.7 | Usage Note..... | 799 |
| 25.6 | Operational Timing | 800 |
| 25.6.1 | Clock Timing | 800 |
| 25.6.2 | Control Signal Timing | 802 |
| 25.6.3 | Bus Timing | 803 |
| 25.6.4 | Timing of On-Chip Supporting Modules..... | 807 |
| Appendix A Instruction Set | | 813 |
| A.1 | Instruction | 813 |

| | | |
|--|---|------|
| A.2 | Instruction Codes | 831 |
| A.3 | Operation Code Map..... | 845 |
| A.4 | Number of States Required for Execution | 849 |
| A.5 | Bus States during Instruction Execution | 862 |
| Appendix B Internal I/O Registers | | 878 |
| B.1 | Addresses | 878 |
| B.2 | Register Selection Conditions | 884 |
| B.3 | Functions..... | 891 |
| Appendix C I/O Port Block Diagrams..... | | 965 |
| C.1 | Port 1 Block Diagram | 965 |
| C.2 | Port 2 Block Diagrams..... | 966 |
| C.3 | Port 3 Block Diagram | 969 |
| C.4 | Port 4 Block Diagrams..... | 970 |
| C.5 | Port 5 Block Diagrams..... | 977 |
| C.6 | Port 6 Block Diagrams..... | 980 |
| C.7 | Port 7 Block Diagrams..... | 985 |
| C.8 | Port 8 Block Diagrams..... | 986 |
| C.9 | Port 9 Block Diagrams..... | 992 |
| Appendix D Pin States | | 997 |
| D.1 | Port States in Each Processing State | 997 |
| Appendix E Timing of Transition to and Recovery from Hardware Standby Mode..... | | 999 |
| E.1 | Timing of Transition to Hardware Standby Mode | 999 |
| E.2 | Timing of Recovery from Hardware Standby Mode..... | 999 |
| Appendix F Product Code Lineup | | 1000 |
| Appendix G Package Dimensions | | 1002 |

Figures

Section 1 Overview

| | | |
|------------|---|----|
| Figure 1.1 | Internal Block Diagram of H8S/2138 Group..... | 7 |
| Figure 1.2 | Internal Block Diagram of H8S/2134 Group..... | 8 |
| Figure 1.3 | Pin Arrangement of H8S/2138 Group (FP-80A, TFP-80C: Top View) | 9 |
| Figure 1.4 | Pin Arrangement of H8S/2134 Group (FP-80A, TFP-80C: Top View) | 10 |

Section 2 CPU

| | | |
|-------------|--|----|
| Figure 2.1 | CPU Operating Modes..... | 28 |
| Figure 2.2 | Exception Vector Table (Normal Mode) | 29 |
| Figure 2.3 | Stack Structure in Normal Mode | 30 |
| Figure 2.4 | Exception Vector Table (Advanced Mode) | 31 |
| Figure 2.5 | Stack Structure in Advanced Mode | 32 |
| Figure 2.6 | Memory Map..... | 33 |
| Figure 2.7 | CPU Registers | 34 |
| Figure 2.8 | Usage of General Registers | 35 |
| Figure 2.9 | Stack | 36 |
| Figure 2.10 | General Register Data Formats..... | 39 |
| Figure 2.11 | Memory Data Formats..... | 41 |
| Figure 2.12 | Instruction Formats (Examples) | 54 |
| Figure 2.13 | Branch Address Specification in Memory Indirect Mode | 57 |
| Figure 2.14 | Processing States | 62 |
| Figure 2.15 | State Transitions | 63 |
| Figure 2.16 | Stack Structure after Exception Handling (Examples) | 65 |
| Figure 2.17 | On-Chip Memory Access Cycle..... | 67 |
| Figure 2.18 | Pin States during On-Chip Memory Access..... | 67 |
| Figure 2.19 | On-Chip Supporting Module Access Cycle..... | 68 |
| Figure 2.20 | Pin States during On-Chip Supporting Module Access..... | 69 |

Section 3 MCU Operating Modes

| | | |
|------------|--|----|
| Figure 3.1 | H8S/2138 (Except for F-ZTAT A-Mask Version) and H8S/2134 Memory Map in Each Operating Mode..... | 80 |
| Figure 3.2 | H8S/2138 F-ZTAT A-Mask Version Memory Map in Each Operating Mode | 82 |
| Figure 3.3 | H8S/2133 Memory Map in Each Operating Mode..... | 84 |
| Figure 3.4 | H8S/2137 and H8S/2132 Memory Map in Each Operating Mode..... | 86 |
| Figure 3.5 | H8S/2130 Memory Map in Each Operating Mode..... | 88 |

Section 4 Exception Handling

| | | |
|------------|-------------------------|----|
| Figure 4.1 | Exception Sources | 92 |
|------------|-------------------------|----|

| | | |
|----------------|--|-----|
| Figure 4.2 | Reset Sequence (Mode 3)..... | 95 |
| Figure 4.3 | Reset Sequence (Mode 1)..... | 96 |
| Figure 4.4 | Interrupt Sources and Number of Interrupts..... | 97 |
| Figure 4.5 (1) | Stack Status after Exception Handling (Normal Mode)..... | 99 |
| Figure 4.5 (2) | Stack Status after Exception Handling (Advanced Mode)..... | 99 |
| Figure 4.6 | Operation When SP Value Is Odd..... | 100 |

Section 5 Interrupt Controller

| | | |
|-------------|--|-----|
| Figure 5.1 | Block Diagram of Interrupt Controller..... | 102 |
| Figure 5.2 | Relationship between Interrupts IRQ6, Interrupts KIN7 to KIN0, and Registers KMIMR..... | 110 |
| Figure 5.3 | Block Diagram of Interrupts IRQ7 to IRQ0..... | 114 |
| Figure 5.4 | Timing of IRQnF Setting..... | 114 |
| Figure 5.5 | Block Diagram of Address Break Function..... | 118 |
| Figure 5.6 | Examples of Address Break Timing..... | 120 |
| Figure 5.7 | Block Diagram of Interrupt Control Operation..... | 122 |
| Figure 5.8 | Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 0..... | 125 |
| Figure 5.9 | Example of State Transitions in Interrupt Control Mode 1..... | 126 |
| Figure 5.10 | Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 1..... | 128 |
| Figure 5.11 | Interrupt Exception Handling..... | 130 |
| Figure 5.12 | Contention between Interrupt Generation and Disabling..... | 132 |
| Figure 5.13 | Interrupt Control for DTC..... | 134 |

Section 6 Bus Controller

| | | |
|----------------|--|-----|
| Figure 6.1 | Block Diagram of Bus Controller..... | 138 |
| Figure 6.2 | $\overline{\text{IOS}}$ Signal Output Timing..... | 145 |
| Figure 6.3 | Access Sizes and Data Alignment Control (8-Bit Access Space)..... | 146 |
| Figure 6.4 | Access Sizes and Data Alignment Control (16-Bit Access Space)..... | 147 |
| Figure 6.5 | Bus Timing for 8-Bit 2-State Access Space..... | 149 |
| Figure 6.6 | Bus Timing for 8-Bit 3-State Access Space..... | 150 |
| Figure 6.7 | Example of Wait State Insertion Timing..... | 152 |
| Figure 6.8 (a) | Example of Burst ROM Access Timing (When AST = BRSTS1 = 1)..... | 154 |
| Figure 6.8 (b) | Example of Burst ROM Access Timing (When AST = BRSTS1 = 0)..... | 154 |
| Figure 6.9 | Example of Idle Cycle Operation..... | 156 |

Section 7 Data Transfer Controller [H8S/2138 Group]

| | | |
|------------|---|-----|
| Figure 7.1 | Block Diagram of DTC..... | 160 |
| Figure 7.2 | Flowchart of DTC Operation..... | 169 |
| Figure 7.3 | Block Diagram of DTC Activation Source Control..... | 172 |

| | | |
|-------------|--|-----|
| Figure 7.4 | Correspondence between DTC Vector Address and Register Information | 173 |
| Figure 7.5 | Location of DTC Register Information in Address Space | 175 |
| Figure 7.6 | Memory Mapping in Normal Mode | 176 |
| Figure 7.7 | Memory Mapping in Repeat Mode..... | 177 |
| Figure 7.8 | Memory Mapping in Block Transfer Mode..... | 179 |
| Figure 7.9 | Memory Mapping in Chain Transfer | 180 |
| Figure 7.10 | DTC Operation Timing (Normal Mode or Repeat Mode)..... | 181 |
| Figure 7.11 | DTC Operation Timing (Block Transfer Mode, with Block Size of 2)..... | 181 |
| Figure 7.12 | DTC Operation Timing (Chain Transfer)..... | 182 |

Section 8 I/O Ports

| | | |
|-------------|---|-----|
| Figure 8.1 | Port 1 Pin Functions | 196 |
| Figure 8.2 | Port 1 Pin Functions (Mode 1) | 199 |
| Figure 8.3 | Port 1 Pin Functions (Modes 2 and 3 (EXPE = 1)) | 199 |
| Figure 8.4 | Port 1 Pin Functions (Modes 2 and 3 (EXPE = 0)) | 200 |
| Figure 8.5 | Port 2 Pin Functions | 202 |
| Figure 8.6 | Port 2 Pin Functions (Mode 1) | 205 |
| Figure 8.7 | Port 2 Pin Functions (Modes 2 and 3 (EXPE = 1)) | 206 |
| Figure 8.8 | Port 2 Pin Functions (Modes 2 and 3 (EXPE = 0)) | 206 |
| Figure 8.9 | Port 3 Pin Functions | 208 |
| Figure 8.10 | Port 3 Pin Functions (Modes 1, 2, and 3 (EXPE = 1)) | 211 |
| Figure 8.11 | Port 3 Pin Functions (Modes 2 and 3 (EXPE = 0)) | 211 |
| Figure 8.12 | Port 4 Pin Functions | 213 |
| Figure 8.13 | Port 5 Pin Functions | 218 |
| Figure 8.14 | Port 6 Pin Functions | 221 |
| Figure 8.15 | Port 7 Pin Functions | 228 |
| Figure 8.16 | Port 8 Pin Functions | 230 |
| Figure 8.17 | Port 9 Pin Functions | 234 |

Section 9 8-Bit PWM Timers [H8S/2138 Group]

| | | |
|------------|---|-----|
| Figure 9.1 | Block Diagram of PWM Timer Module..... | 242 |
| Figure 9.2 | Example of Additional Pulse Timing (When Upper 4 Bits of PWDR = 1000)..... | 252 |

Section 10 14-Bit PWM D/A

| | | |
|-----------------|---|-----|
| Figure 10.1 | PWM D/A Block Diagram | 254 |
| Figure 10.2 (a) | Access to DACNT (CPU Writes H'AA57 to DACNT)..... | 263 |
| Figure 10.2 (b) | Access to DACNT (CPU Reads H'AA57 from DACNT) | 264 |
| Figure 10.3 | PWM D/A Operation..... | 265 |
| Figure 10.4 (1) | Output Waveform..... | 267 |
| Figure 10.4 (2) | Output Waveform..... | 267 |

| | |
|--------------------------------------|-----|
| Figure 10.4 (3) Output Waveform..... | 268 |
| Figure 10.4 (4) Output Waveform..... | 268 |

Section 11 16-Bit Free-Running Timer

| | | |
|--------------|---|-----|
| Figure 11.1 | Block Diagram of 16-Bit Free-Running Timer | 270 |
| Figure 11.2 | Input Capture Buffering (Example)..... | 274 |
| Figure 11.3 | Increment Timing with Internal Clock Source | 287 |
| Figure 11.4 | Increment Timing with External Clock Source | 288 |
| Figure 11.5 | Timing of Output Compare A Output | 288 |
| Figure 11.6 | Clearing of FRC by Compare-Match A..... | 289 |
| Figure 11.7 | Input Capture Signal Timing (Usual Case)..... | 289 |
| Figure 11.8 | Input Capture Signal Timing (Input Capture Input When ICRA/B/C/D Is Read)..... | 290 |
| Figure 11.9 | Buffered Input Capture Timing (Usual Case)..... | 290 |
| Figure 11.10 | Buffered Input Capture Timing (Input Capture Input When ICRA or ICRC Is Read) | 291 |
| Figure 11.11 | Setting of Input Capture Flag (ICFA to ICFD)..... | 292 |
| Figure 11.12 | Setting of Output Compare Flag (OCFA, OCFB) | 293 |
| Figure 11.13 | Setting of Overflow Flag (OVF)..... | 294 |
| Figure 11.14 | OCRA Automatic Addition Timing | 294 |
| Figure 11.15 | Input Capture Mask Signal Setting Timing | 295 |
| Figure 11.16 | Input Capture Mask Signal Clearing Timing..... | 295 |
| Figure 11.17 | Pulse Output (Example) | 297 |
| Figure 11.18 | FRC Write-Clear Contention..... | 298 |
| Figure 11.19 | FRC Write-Increment Contention | 299 |
| Figure 11.20 | Contention between OCR Write and Compare-Match (When Automatic Addition Function Is Not Used)..... | 300 |
| Figure 11.21 | Contention between OCRAR/OCRAF Write and Compare-Match (When Automatic Addition Function Is Used)..... | 301 |

Section 12 8-Bit Timers

| | | |
|-------------|---|-----|
| Figure 12.1 | Block Diagram of 8-Bit Timer Module | 306 |
| Figure 12.2 | Count Timing for Internal Clock Input..... | 325 |
| Figure 12.3 | Count Timing for External Clock Input..... | 326 |
| Figure 12.4 | Timing of CMF Setting | 326 |
| Figure 12.5 | Timing of Timer Output | 327 |
| Figure 12.6 | Timing of Compare-Match Clear | 327 |
| Figure 12.7 | Timing of Clearing by External Reset Input..... | 328 |
| Figure 12.8 | Timing of OVF Setting..... | 328 |
| Figure 12.9 | Timing of Input Capture Operation | 330 |

| | | |
|--------------|---|-----|
| Figure 12.10 | Timing of Input Capture Signal (When Input Capture Input Signal Enters while TICRR and TICRF Are Being Read)..... | 331 |
| Figure 12.11 | Switching of Input Capture Signal | 331 |
| Figure 12.12 | Pulse Output (Example) | 334 |
| Figure 12.13 | Contention between TCNT Write and Clear | 335 |
| Figure 12.14 | Contention between TCNT Write and Increment..... | 336 |
| Figure 12.15 | Contention between TCOR Write and Compare-Match..... | 337 |

Section 13 Timer Connection [H8S/2138 Group]

| | | |
|-------------|---|-----|
| Figure 13.1 | Block Diagram of Timer Connection Facility | 342 |
| Figure 13.2 | Timing Chart for PWM Decoding..... | 356 |
| Figure 13.3 | Timing Chart for Clamp Waveform Generation (CL1 and CL2 Signals) | 358 |
| Figure 13.4 | Timing Chart for Clamp Waveform Generation (CL3 Signal)..... | 358 |
| Figure 13.5 | Timing Chart for Measurement of IVI Signal and IHI Signal Divided Waveform Periods | 360 |
| Figure 13.6 | 2fH Modification Timing Chart | 361 |
| Figure 13.7 | Fall Modification/IHI Synchronization Timing Chart..... | 363 |
| Figure 13.8 | IVG Signal/IHG Signal/CL4 Signal Timing Chart..... | 366 |
| Figure 13.9 | CBLANK Output Waveform Generation | 369 |

Section 14 Watchdog Timer (WDT)

| | | |
|-----------------|---|-----|
| Figure 14.1 (a) | Block Diagram of WDT0 | 372 |
| Figure 14.1 (b) | Block Diagram of WDT1 | 373 |
| Figure 14.2 | Format of Data Written to TCNT and TCSR (Example of WDT0) | 380 |
| Figure 14.3 | Operation in Watchdog Timer Mode..... | 382 |
| Figure 14.4 | Operation in Interval Timer Mode..... | 383 |
| Figure 14.5 | Timing of OVF Setting..... | 383 |
| Figure 14.6 | Contention between TCNT Write and Increment..... | 384 |

Section 15 Serial Communication Interface (SCI, IrDA)

| | | |
|-------------|--|-----|
| Figure 15.1 | Block Diagram of SCI..... | 389 |
| Figure 15.2 | Data Format in Asynchronous Communication (Example with 8-Bit Data, Parity, Two Stop Bits) | 419 |
| Figure 15.3 | Relation between Output Clock and Transfer Data Phase (Asynchronous Mode) | 421 |
| Figure 15.4 | Sample SCI Initialization Flowchart | 422 |
| Figure 15.5 | Sample Serial Transmission Flowchart | 423 |
| Figure 15.6 | Example of Operation in Transmission in Asynchronous Mode (Example with 8-Bit Data, Parity, One Stop Bit) | 425 |
| Figure 15.7 | Sample Serial Reception Data Flowchart | 426 |

| | | |
|--------------|--|-----|
| Figure 15.8 | Example of SCI Operation in Reception (Example with 8-Bit Data, Parity, One Stop Bit) | 429 |
| Figure 15.9 | Example of Inter-Processor Communication Using Multiprocessor Format (Transmission of Data H'AA to Receiving Station A) | 431 |
| Figure 15.10 | Sample Multiprocessor Serial Transmission Flowchart | 432 |
| Figure 15.11 | Example of SCI Operation in Transmission (Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit) | 434 |
| Figure 15.12 | Sample Multiprocessor Serial Reception Flowchart..... | 435 |
| Figure 15.13 | Example of SCI Operation in Reception (Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit) | 437 |
| Figure 15.14 | Data Format in Synchronous Communication..... | 438 |
| Figure 15.15 | Sample SCI Initialization Flowchart | 440 |
| Figure 15.16 | Sample Serial Transmission Flowchart | 441 |
| Figure 15.17 | Example of SCI Operation in Transmission | 443 |
| Figure 15.18 | Sample Serial Reception Flowchart..... | 444 |
| Figure 15.19 | Example of SCI Operation in Reception | 445 |
| Figure 15.20 | Sample Flowchart of Simultaneous Serial Transmit and Receive Operations... | 446 |
| Figure 15.21 | Block Diagram of IrDA Function..... | 447 |
| Figure 15.22 | IrDA Transmit/Receive Operations | 448 |
| Figure 15.23 | Receive Data Sampling Timing in Asynchronous Mode | 453 |
| Figure 15.24 | Example of Synchronous Transmission by DTC | 454 |

Section 16 I²C Bus Interface [H8S/2138 Group Option]

| | | |
|-----------------|---|-----|
| Figure 16.1 | Block Diagram of I ² C Bus Interface | 457 |
| Figure 16.2 | I ² C Bus Interface Connections (Example: H8S/2138 Group Chip as Master)... | 458 |
| Figure 16.3 | I ² C Bus Data Formats (I ² C Bus Formats)..... | 485 |
| Figure 16.4 | Formatless..... | 486 |
| Figure 16.5 | I ² C Bus Data Format (Serial Format) | 486 |
| Figure 16.6 | I ² C Bus Timing | 486 |
| Figure 16.7 | Example of Master Transmit Mode Operation Timing (MLS = WAIT = 0)..... | 489 |
| Figure 16.8 (a) | Example of Master Receive Mode Operation Timing (MLS = ACKB = 0, WAIT = 1) | 491 |
| Figure 16.8 (b) | Example of Master Receive Mode Operation Timing (MLS = ACKB = 0, WAIT = 1) (cont)..... | 491 |
| Figure 16.9 | Example of Slave Receive Mode Operation Timing (1) (MLS = ACKB = 0) .. | 493 |
| Figure 16.10 | Example of Slave Receive Mode Operation Timing (2) (MLS = ACKB = 0) .. | 494 |
| Figure 16.11 | Example of Slave Transmit Mode Operation Timing (MLS = 0)..... | 496 |
| Figure 16.12 | IRIC Setting Timing and SCL Control | 497 |
| Figure 16.13 | Block Diagram of Noise Canceler..... | 500 |
| Figure 16.14 | Flowchart for Master Transmit Mode (Example)..... | 501 |
| Figure 16.15 | Flowchart for Master Receive Mode (Example) | 502 |

| | | |
|---|---|-----|
| Figure 16.16 | Flowchart for Slave Receive Mode (Example)..... | 503 |
| Figure 16.17 | Flowchart for Slave Transmit Mode (Example)..... | 504 |
| Figure 16.18 | Points for Attention Concerning Reading of Master Receive Data | 511 |
| Figure 16.19 | Flowchart and Timing of Start Condition Instruction Issuance for Retransmission..... | 512 |
| Figure 16.20 | Timing of Stop Condition Issuance | 513 |
| Figure 16.21 | IRIC Flag Clear Timing on WAIT Operation | 514 |
| Figure 16.22 | ICDR Read and ICCR Access Timing in Slave Transmit Mode..... | 515 |
| Figure 16.23 | TRS Bit Setting Timing in Slave Mode..... | 516 |
| Figure 16.24 | Diagram of Erroneous Operation when Arbitration is Lost..... | 517 |
| Figure 16.25 | Note on Interrupt Occurrence in Slave Mode after ACKB = 1 Reception | 519 |
| Figure 16.26 | Notes on ICDR Reading with TRS = 1 Setting in Master Mode..... | 521 |
| Figure 16.27 | Notes on ICDR Writing with TRS = 0 Setting in Slave Mode..... | 521 |
| Section 17 Host Interface [H8S/2138 Group] | | |
| Figure 17.1 | Block Diagram of Host Interface..... | 524 |
| Figure 17.2 | GA20 Output | 538 |
| Figure 17.3 | HIRQ Output Flowchart | 542 |
| Section 18 D/A Converter | | |
| Figure 18.1 | Block Diagram of D/A Converter..... | 544 |
| Figure 18.2 | D/A Conversion (Example)..... | 549 |
| Section 19 A/D Converter | | |
| Figure 19.1 | Block Diagram of A/D Converter..... | 552 |
| Figure 19.2 | ADDR Access Operation (Reading H'AA40) | 561 |
| Figure 19.3 | Example of A/D Converter Operation (Single Mode, Channel 1 Selected) | 563 |
| Figure 19.4 | Example of A/D Converter Operation (Scan Mode, Channels AN0 to AN2 Selected) | 565 |
| Figure 19.5 | A/D Conversion Timing | 566 |
| Figure 19.6 | External Trigger Input Timing | 567 |
| Figure 19.7 | Example of Analog Input Protection Circuit | 569 |
| Figure 19.8 | Analog Input Pin Equivalent Circuit | 569 |
| Figure 19.9 | A/D Conversion Precision Definitions (1)..... | 571 |
| Figure 19.10 | A/D Conversion Precision Definitions (2)..... | 571 |
| Figure 19.11 | Example of Analog Input Circuit | 572 |
| Section 20 RAM | | |
| Figure 20.1 | Block Diagram of RAM (H8S/2138, H8S/2134, H8S/2133) | 573 |

Section 21 ROM (Mask ROM Version, H8S/2138 F-ZTAT, H8S/2134 F-ZTAT, and H8S/2132 F-ZTAT)

| | | |
|--------------|---|-----|
| Figure 21.1 | ROM Block Diagram (H8S/2138, H8S/2134)..... | 577 |
| Figure 21.2 | Block Diagram of Flash Memory | 581 |
| Figure 21.3 | Flash Memory Mode Transitions..... | 582 |
| Figure 21.4 | Boot Mode | 583 |
| Figure 21.5 | User Program Mode (Example)..... | 584 |
| Figure 21.6 | Flash Memory Block Configuration..... | 585 |
| Figure 21.7 | System Configuration in Boot Mode..... | 594 |
| Figure 21.8 | Boot Mode Execution Procedure..... | 595 |
| Figure 21.9 | RxD1 Input Signal When Using Automatic SCI Bit Rate Adjustment | 596 |
| Figure 21.10 | RAM Areas in Boot Mode..... | 597 |
| Figure 21.11 | User Program Mode Execution Procedure | 599 |
| Figure 21.12 | Program/Program-Verify Flowchart..... | 602 |
| Figure 21.13 | Erase/Erase-Verify Flowchart (Single-Block Erase) | 604 |
| Figure 21.14 | Flash Memory State Transitions | 607 |
| Figure 21.15 | Memory Map in Programmer Mode..... | 610 |
| Figure 21.16 | Memory Read Mode Timing Waveforms after Command Write | 612 |
| Figure 21.17 | Timing Waveforms When Entering Another Mode from Memory Read Mode | 613 |
| Figure 21.18 | Timing Waveforms for $\overline{CE}/\overline{OE}$ Enable State Read..... | 614 |
| Figure 21.19 | Timing Waveforms for $\overline{CE}/\overline{OE}$ Clocked Read | 614 |
| Figure 21.20 | Auto-Program Mode Timing Waveforms..... | 616 |
| Figure 21.21 | Auto-Erase Mode Timing Waveforms | 617 |
| Figure 21.22 | Status Read Mode Timing Waveforms..... | 619 |
| Figure 21.23 | Oscillation Stabilization Time, Programmer Mode Setup Time, and Power Supply Fall Sequence | 620 |

Section 22 ROM (H8S/2138 F-ZTAT A-Mask Version, H8S/2134 F-ZTAT A-Mask Version)

| | | |
|--------------|---|-----|
| Figure 22.1 | ROM Block Diagram..... | 623 |
| Figure 22.2 | Block Diagram of Flash Memory | 627 |
| Figure 22.3 | Flash Memory Mode Transitions..... | 628 |
| Figure 22.4 | Boot Mode | 629 |
| Figure 22.5 | User Program Mode (Example)..... | 630 |
| Figure 22.6 | Flash Memory Block Configuration..... | 631 |
| Figure 22.7 | System Configuration in Boot Mode..... | 640 |
| Figure 22.8 | Boot Mode Execution Procedure..... | 641 |
| Figure 22.9 | Automatic SCI Bit Rate Adjustment | 642 |
| Figure 22.10 | RAM Areas in Boot Mode..... | 643 |
| Figure 22.11 | User Program Mode Execution Procedure | 645 |

| | | |
|--------------|---|-----|
| Figure 22.12 | Program/Program-Verify Flowchart..... | 648 |
| Figure 22.13 | Erase/Erase-Verify Flowchart (Single-Block Erase)..... | 650 |
| Figure 22.14 | Flash Memory State Transitions..... | 653 |
| Figure 22.15 | Memory Map in Programmer Mode..... | 656 |
| Figure 22.16 | Memory Read Mode Timing Waveforms after Command Write..... | 658 |
| Figure 22.17 | Timing Waveforms when Entering Another Mode from Memory Read Mode | 659 |
| Figure 22.18 | Timing Waveforms for $\overline{CE}/\overline{OE}$ Enable State Read..... | 660 |
| Figure 22.19 | Timing Waveforms for $\overline{CE}/\overline{OE}$ Clocked Read | 660 |
| Figure 22.20 | Auto-Program Mode Timing Waveforms..... | 662 |
| Figure 22.21 | Auto-Erase Mode Timing Waveforms | 663 |
| Figure 22.22 | Status Read Mode Timing Waveforms..... | 665 |
| Figure 22.23 | Oscillation Stabilization Time, Programmer Mode Setup Time, and Power Supply Fall Sequence | 666 |

Section 23 Clock Pulse Generator

| | | |
|-------------|---|-----|
| Figure 23.1 | Block Diagram of Clock Pulse Generator | 669 |
| Figure 23.2 | Connection of Crystal Resonator (Example)..... | 672 |
| Figure 23.3 | Crystal Resonator Equivalent Circuit | 672 |
| Figure 23.4 | Example of Incorrect Board Design | 673 |
| Figure 23.5 | External Clock Input (Examples) | 674 |
| Figure 23.6 | External Clock Input Timing | 675 |
| Figure 23.7 | External Clock Output Settling Delay Timing | 676 |
| Figure 23.8 | Subclock Input Timing | 678 |

Section 24 Power-Down State

| | | |
|-------------|--|-----|
| Figure 24.1 | Mode Transitions..... | 683 |
| Figure 24.2 | Medium-Speed Mode Transition and Clearance Timing..... | 692 |
| Figure 24.3 | Software Standby Mode Application Example | 697 |
| Figure 24.4 | Hardware Standby Mode Timing | 698 |

Section 25 Electrical Characteristics

| | | |
|-------------|--|-----|
| Figure 25.1 | Darlington Pair Drive Circuit (Example) | 717 |
| Figure 25.2 | LED Drive Circuit (Example) | 717 |
| Figure 25.3 | Connection of External Capacitor (Mask ROM Type Incorporating Step-Down Circuit and Product Not Incorporating Step-Down Circuit)..... | 732 |
| Figure 25.4 | Output Load Circuit..... | 800 |
| Figure 25.5 | System Clock Timing | 800 |
| Figure 25.6 | Oscillation Settling Timing | 801 |
| Figure 25.7 | Oscillation Setting Timing (Exiting Software Standby Mode)..... | 801 |
| Figure 25.8 | Reset Input Timing | 802 |

| | | |
|--------------|---|-----|
| Figure 25.9 | Interrupt Input Timing | 802 |
| Figure 25.10 | Basic Bus Timing (Two-State Access) | 803 |
| Figure 25.11 | Basic Bus Timing (Three-State Access) | 804 |
| Figure 25.12 | Basic Bus Timing (Three-State Access with One Wait State) | 805 |
| Figure 25.13 | Burst ROM Access Timing (Two-State Access) | 806 |
| Figure 25.14 | Burst ROM Access Timing (One-State Access) | 807 |
| Figure 25.15 | I/O Port Input/Output Timing | 807 |
| Figure 25.16 | FRT Input/Output Timing | 808 |
| Figure 25.17 | FRT Clock Input Timing | 808 |
| Figure 25.18 | 8-Bit Timer Output Timing | 808 |
| Figure 25.19 | 8-Bit Timer Clock Input Timing | 809 |
| Figure 25.20 | 8-Bit Timer Reset Input Timing | 809 |
| Figure 25.21 | PWM, PWMX Output Timing | 809 |
| Figure 25.22 | SCK Clock Input Timing | 809 |
| Figure 25.23 | SCI Input/Output Timing (Synchronous Mode) | 810 |
| Figure 25.24 | A/D Converter External Trigger Input Timing | 810 |
| Figure 25.25 | Host Interface Timing | 811 |
| Figure 25.26 | I ² C Bus Interface Input/Output Timing (Option) | 812 |

Appendix A Instruction Set

| | | |
|------------|---|-----|
| Figure A.1 | Address Bus, \overline{RD} and \overline{WR} Timing (8-Bit Bus, Three-State Access, No Wait States) | 863 |
|------------|---|-----|

Appendix C I/O Port Block Diagrams

| | | |
|-------------|--|-----|
| Figure C.1 | Port 1 Block Diagram | 965 |
| Figure C.2 | Port 2 Block Diagram (Pins P20 to P23) | 966 |
| Figure C.3 | Port 2 Block Diagram (Pins P24 to P26) | 967 |
| Figure C.4 | Port 2 Block Diagram (Pin P27) | 968 |
| Figure C.5 | Port 3 Block Diagram | 969 |
| Figure C.6 | Port 4 Block Diagram (Pin P40) | 970 |
| Figure C.7 | Port 4 Block Diagram (Pin P41) | 971 |
| Figure C.8 | Port 4 Block Diagram (Pin P42) | 972 |
| Figure C.9 | Port 4 Block Diagram (Pin P43) | 973 |
| Figure C.10 | Port 4 Block Diagram (Pin P44) | 974 |
| Figure C.11 | Port 4 Block Diagram (Pin P45) | 975 |
| Figure C.12 | Port 4 Block Diagram (Pins P46, P47) | 976 |
| Figure C.13 | Port 5 Block Diagram (Pin P50) | 977 |
| Figure C.14 | Port 5 Block Diagram (Pin P51) | 978 |
| Figure C.15 | Port 5 Block Diagram (Pin P52) | 979 |
| Figure C.16 | Port 6 Block Diagram (Pins P60, P62, P63, P65) | 980 |
| Figure C.17 | Port 6 Block Diagram (Pin P61) | 981 |

| | | |
|-------------|---|-----|
| Figure C.18 | Port 6 Block Diagram (Pin P64)..... | 982 |
| Figure C.19 | Port 6 Block Diagram (Pin P66)..... | 983 |
| Figure C.20 | Port 6 Block Diagram (Pin P67)..... | 984 |
| Figure C.21 | Port 7 Block Diagram (Pins P70 to P75)..... | 985 |
| Figure C.22 | Port 7 Block Diagram (Pins P76, P77)..... | 985 |
| Figure C.23 | Port 8 Block Diagram (Pin P80)..... | 986 |
| Figure C.24 | Port 8 Block Diagram (Pin P81)..... | 987 |
| Figure C.25 | Port 8 Block Diagram (Pins P82, P83)..... | 988 |
| Figure C.26 | Port 8 Block Diagram (Pin P84)..... | 989 |
| Figure C.27 | Port 8 Block Diagram (Pin P85)..... | 990 |
| Figure C.28 | Port 8 Block Diagram (Pin P86)..... | 991 |
| Figure C.29 | Port 9 Block Diagram (Pin P90)..... | 992 |
| Figure C.30 | Port 9 Block Diagram (Pins P91, P92)..... | 993 |
| Figure C.31 | Port 9 Block Diagram (Pins P93 to P95)..... | 994 |
| Figure C.32 | Port 9 Block Diagram (Pin P96)..... | 995 |
| Figure C.33 | Port 9 Block Diagram (Pin P97)..... | 996 |

Appendix E Timing of Transition to and Recovery from Hardware Standby Mode

| | | |
|------------|--|-----|
| Figure E.1 | Timing of Transition to Hardware Standby Mode..... | 999 |
| Figure E.2 | Timing of Recovery from Hardware Standby Mode..... | 999 |

Appendix G Package Dimensions

| | | |
|------------|-----------------------------------|------|
| Figure G.1 | Package Dimensions (FP-80A)..... | 1002 |
| Figure G.2 | Package Dimensions (TFP-80C)..... | 1003 |

Tables

Section 1 Overview

| | | |
|-----------|---|----|
| Table 1.1 | Overview | 2 |
| Table 1.2 | H8S/2138 Group Pin Functions in Each Operating Mode | 11 |
| Table 1.3 | H8S/2134 Group Pin Functions in Each Operating Mode | 15 |
| Table 1.4 | Pin Functions..... | 18 |

Section 2 CPU

| | | |
|-----------|--|----|
| Table 2.1 | Instruction Classification..... | 42 |
| Table 2.2 | Combinations of Instructions and Addressing Modes..... | 43 |
| Table 2.3 | Instructions Classified by Function | 45 |
| Table 2.4 | Addressing Modes..... | 55 |
| Table 2.5 | Absolute Address Access Ranges | 56 |
| Table 2.6 | Effective Address Calculation..... | 59 |
| Table 2.7 | Exception Handling Types and Priority | 64 |

Section 3 MCU Operating Modes

| | | |
|-----------|-----------------------------------|----|
| Table 3.1 | MCU Operating Mode Selection..... | 71 |
| Table 3.2 | MCU Registers..... | 72 |
| Table 3.3 | Pin Functions in Each Mode | 79 |

Section 4 Exception Handling

| | | |
|-----------|---|----|
| Table 4.1 | Exception Types and Priority | 91 |
| Table 4.2 | Exception Vector Table..... | 93 |
| Table 4.3 | Status of CCR and EXR after Trap Instruction Exception Handling | 98 |

Section 5 Interrupt Controller

| | | |
|------------|--|-----|
| Table 5.1 | Interrupt Controller Pins..... | 102 |
| Table 5.2 | Interrupt Controller Registers..... | 103 |
| Table 5.3 | Correspondence between Interrupt Sources and ICR Settings | 105 |
| Table 5.4 | Interrupt Sources, Vector Addresses, and Interrupt Priorities | 116 |
| Table 5.5 | Interrupt Control Modes..... | 121 |
| Table 5.6 | Interrupts Selected in Each Interrupt Control Mode | 123 |
| Table 5.7 | Operations and Control Signal Functions in Each Interrupt Control Mode | 123 |
| Table 5.8 | Interrupt Response Times..... | 131 |
| Table 5.9 | Number of States in Interrupt Handling Routine Execution | 131 |
| Table 5.10 | Interrupt Source Selection and Clearing Control | 135 |

Section 6 Bus Controller

| | | |
|-----------|--|-----|
| Table 6.1 | Bus Controller Pins | 139 |
| Table 6.2 | Bus Controller Registers | 139 |
| Table 6.3 | Bus Specifications for Each Area (Basic Bus Interface) | 144 |
| Table 6.4 | $\overline{\text{IOS}}$ Signal Output Range Settings | 145 |
| Table 6.5 | Data Buses Used and Valid Strobes | 148 |
| Table 6.6 | Pin States in Idle Cycle | 156 |

Section 7 Data Transfer Controller [H8S/2138 Group]

| | | |
|-----------|--|-----|
| Table 7.1 | DTC Registers | 161 |
| Table 7.2 | DTC Functions | 170 |
| Table 7.3 | Activation Sources and DTCER Clearing | 171 |
| Table 7.4 | Interrupt Sources, DTC Vector Addresses, and Corresponding DTCEs | 174 |
| Table 7.5 | Register Information in Normal Mode | 176 |
| Table 7.6 | Register Information in Repeat Mode | 177 |
| Table 7.7 | Register Information in Block Transfer Mode | 178 |
| Table 7.8 | DTC Execution Phases | 182 |
| Table 7.9 | Number of States Required for Each Execution Phase | 183 |

Section 8 I/O Ports

| | | |
|------------|---|-----|
| Table 8.1 | H8S/2138 Group Port Functions | 190 |
| Table 8.2 | H8S/2134 Group Port Functions | 193 |
| Table 8.3 | Port 1 Registers | 197 |
| Table 8.4 | MOS Input Pull-Up States (Port 1) | 201 |
| Table 8.5 | Port 2 Registers | 203 |
| Table 8.6 | MOS Input Pull-Up States (Port 2) | 207 |
| Table 8.7 | Port 3 Registers | 209 |
| Table 8.8 | MOS Input Pull-Up States (Port 3) | 212 |
| Table 8.9 | Port 4 Registers | 213 |
| Table 8.10 | Port 4 Pin Functions | 215 |
| Table 8.11 | Port 5 Registers | 218 |
| Table 8.12 | Port 5 Pin Functions | 220 |
| Table 8.13 | Port 6 Registers | 222 |
| Table 8.14 | Port 6 Pin Functions | 225 |
| Table 8.15 | MOS Input Pull-Up States (Port 6) | 227 |
| Table 8.16 | Port 7 Registers | 228 |
| Table 8.17 | Port 8 Registers | 230 |
| Table 8.18 | Port 8 Pin Functions | 232 |
| Table 8.19 | Port 9 Registers | 235 |
| Table 8.20 | Port 9 Pin Functions | 237 |

Section 9 8-Bit PWM Timers [H8S/2138 Group]

| | | |
|-----------|--|-----|
| Table 9.1 | Pin Configuration | 243 |
| Table 9.2 | PWM Timer Module Registers | 243 |
| Table 9.3 | Resolution, PWM Conversion Period, and Carrier Frequency when $\phi = 20$ MHz | 245 |
| Table 9.4 | Duty Cycle of Basic Pulse | 251 |
| Table 9.5 | Position of Pulses Added to Basic Pulses | 252 |

Section 10 14-Bit PWM D/A

| | | |
|------------|--|-----|
| Table 10.1 | Input and Output Pins | 255 |
| Table 10.2 | Register Configuration | 255 |
| Table 10.3 | Read and Write Access Methods for 16-Bit Registers | 263 |
| Table 10.4 | Settings and Operation (Examples when $\phi = 10$ MHz) | 266 |

Section 11 16-Bit Free-Running Timer

| | | |
|------------|--|-----|
| Table 11.1 | Input and Output Pins of Free-Running Timer Module | 271 |
| Table 11.2 | Register Configuration | 272 |
| Table 11.3 | Buffered Input Capture Edge Selection (Example) | 275 |
| Table 11.4 | Free-Running Timer Interrupts | 296 |
| Table 11.5 | Switching of Internal Clock and FRC Operation | 302 |

Section 12 8-Bit Timers

| | | |
|------------|--|-----|
| Table 12.1 | 8-Bit Timer Input and Output Pins | 307 |
| Table 12.2 | 8-Bit Timer Registers | 308 |
| Table 12.3 | Input Capture Signal Selection | 332 |
| Table 12.4 | TMR0 and TMR1 8-Bit Timer Interrupt Sources | 333 |
| Table 12.5 | TMRX 8-Bit Timer Interrupt Source | 333 |
| Table 12.6 | TMRY 8-Bit Timer Interrupt Sources | 333 |
| Table 12.7 | Timer Output Priorities | 338 |
| Table 12.8 | Switching of Internal Clock and TCNT Operation | 339 |

Section 13 Timer Connection [H8S/2138 Group]

| | | |
|------------|---|-----|
| Table 13.1 | Timer Connection Input and Output Pins | 343 |
| Table 13.2 | Register Configuration | 344 |
| Table 13.3 | Examples of TCR Settings | 356 |
| Table 13.4 | Examples of TCORB (Pulse Width Threshold) Settings | 356 |
| Table 13.5 | Examples of TCR and TCSR Settings | 359 |
| Table 13.6 | Examples of TCR, TCSR, TCOR, and OCRDM Settings | 361 |
| Table 13.7 | Examples of TCORB, TCR, and TCSR Settings | 363 |
| Table 13.8 | Examples of OCRAR, OCRAF, TOCR, TCORA, TCORB, TCR, and TCSR Settings | 365 |

| | | |
|--|---|-----|
| Table 13.9 | Meaning of HSYNCO Output in Each Mode..... | 367 |
| Table 13.10 | Meaning of VSYNCO Output in Each Mode..... | 368 |
| Section 14 Watchdog Timer (WDT) | | |
| Table 14.1 | WDT Pin | 374 |
| Table 14.2 | WDT Registers..... | 374 |
| Section 15 Serial Communication Interface (SCI, IrDA) | | |
| Table 15.1 | SCI Pins..... | 390 |
| Table 15.2 | SCI Registers..... | 391 |
| Table 15.3 | BRR Settings for Various Bit Rates (Asynchronous Mode) | 406 |
| Table 15.4 | BRR Settings for Various Bit Rates (Synchronous Mode) | 409 |
| Table 15.5 | Maximum Bit Rate for Each Frequency (Asynchronous Mode)..... | 411 |
| Table 15.6 | Maximum Bit Rate with External Clock Input (Asynchronous Mode)..... | 412 |
| Table 15.7 | Maximum Bit Rate with External Clock Input (Synchronous Mode)..... | 413 |
| Table 15.8 | SMR Settings and Serial Transfer Format Selection..... | 418 |
| Table 15.9 | SMR and SCR Settings and SCI Clock Source Selection | 418 |
| Table 15.10 | Serial Transfer Formats (Asynchronous Mode) | 420 |
| Table 15.11 | Receive Errors and Conditions for Occurrence..... | 429 |
| Table 15.12 | Bit IrCKS2 to IrCKS0 Settings | 449 |
| Table 15.13 | SCI Interrupt Sources | 450 |
| Table 15.14 | State of SSR Status Flags and Transfer of Receive Data | 451 |
| Section 16 I²C Bus Interface [H8S/2138 Group Option] | | |
| Table 16.1 | I ² C Bus Interface Pins..... | 458 |
| Table 16.2 | Register Configuration | 459 |
| Table 16.3 | Flags and Transfer States | 474 |
| Table 16.4 | I ² C Bus Data Format Symbols..... | 487 |
| Table 16.5 | Examples of Operation Using the DTC..... | 499 |
| Table 16.6 | I ² C Bus Timing (SCL and SDA Output) | 507 |
| Table 16.7 | Permissible SCL Rise Time (t _{sr}) Values | 508 |
| Table 16.8 | I ² C Bus Timing (with Maximum Influence of t _{sr} /t _{sr'})..... | 509 |
| Section 17 Host Interface [H8S/2138 Group] | | |
| Table 17.1 | Host Interface Input/Output Pins..... | 525 |
| Table 17.2 | Host Interface Registers | 526 |
| Table 17.3 | Set/Clear Timing for STR1 Flags..... | 532 |
| Table 17.4 | Set/Clear Timing for STR2 Flags..... | 535 |
| Table 17.5 | Host Interface Channel Selection and Pin Operation | 536 |
| Table 17.6 | Host Interface Operation | 537 |
| Table 17.7 | GA20 (P81) Set/Clear Timing..... | 538 |

| | | |
|-------------|--|-----|
| Table 17.8 | Fast A20 Gate Output Signals | 539 |
| Table 17.9 | Scope of HIF Pin Shutdown in Slave Mode..... | 540 |
| Table 17.10 | Input Buffer Full Interrupts | 541 |
| Table 17.11 | HIRQ Setting/Clearing Conditions..... | 541 |

Section 18 D/A Converter

| | | |
|------------|---|-----|
| Table 18.1 | Input and Output Pins of D/A Converter Module | 545 |
| Table 18.2 | D/A Converter Registers | 545 |

Section 19 A/D Converter

| | | |
|------------|---|-----|
| Table 19.1 | A/D Converter Pins | 553 |
| Table 19.2 | A/D Converter Registers | 554 |
| Table 19.3 | Analog Input Channels and Corresponding ADDR Registers..... | 555 |
| Table 19.4 | A/D Conversion Time (Single Mode) | 566 |
| Table 19.5 | Analog Pin Specifications | 569 |

Section 20 RAM

| | | |
|------------|------------------------------|-----|
| Table 20.1 | Register Configuration | 574 |
|------------|------------------------------|-----|

Section 21 ROM (Mask ROM Version, H8S/2138 F-ZTAT, H8S/2134 F-ZTAT, and H8S/2132 F-ZTAT)

| | | |
|-------------|--|-----|
| Table 21.1 | ROM Register | 578 |
| Table 21.2 | Operating Modes and ROM | 579 |
| Table 21.3 | Flash Memory Pins..... | 586 |
| Table 21.4 | Flash Memory Registers..... | 586 |
| Table 21.5 | Flash Memory Erase Blocks..... | 592 |
| Table 21.6 | Setting On-Board Programming Modes..... | 593 |
| Table 21.7 | System Clock Frequencies for which Automatic Adjustment of H8S/2138 or H8S/2134 Group Bit Rate Is Possible | 596 |
| Table 21.8 | Hardware Protection..... | 605 |
| Table 21.9 | Software Protection | 606 |
| Table 21.10 | Programmer Mode Pin Settings | 609 |
| Table 21.11 | Settings for Each Operating Mode in Programmer Mode | 611 |
| Table 21.12 | Programmer Mode Commands | 611 |
| Table 21.13 | AC Characteristics in Memory Read Mode | 612 |
| Table 21.14 | AC Characteristics When Entering Another Mode from Memory Read Mode | 613 |
| Table 21.15 | AC Characteristics in Memory Read Mode | 614 |
| Table 21.16 | AC Characteristics in Auto-Program Mode | 615 |
| Table 21.17 | AC Characteristics in Auto-Erase Mode | 617 |
| Table 21.18 | AC Characteristics in Status Read Mode | 618 |
| Table 21.19 | Status Read Mode Return Commands..... | 619 |

| | | |
|-------------------|---|-----|
| Table 21.20 | Status Polling Output Truth Table..... | 620 |
| Table 21.21 | Command Wait State Transition Time Specifications | 620 |
| Table 21.22 | Registers Present in F-ZTAT Version but Absent in Mask ROM Version | 622 |
| | | |
| Section 22 | ROM (H8S/2138 F-ZTAT A-Mask Version, H8S/2134 F-ZTAT A-Mask Version) | |
| Table 22.1 | ROM Register | 624 |
| Table 22.2 | Operating Modes and ROM | 625 |
| Table 22.3 | Flash Memory Pins..... | 632 |
| Table 22.4 | Flash Memory Registers..... | 632 |
| Table 22.5 | Flash Memory Erase Blocks..... | 638 |
| Table 22.6 | Setting On-Board Programming Modes | 639 |
| Table 22.7 | System Clock Frequencies for which Automatic Adjustment of the Chip's Bit Rate Is Possible | 642 |
| Table 22.8 | Hardware Protection..... | 651 |
| Table 22.9 | Software Protection | 652 |
| Table 22.10 | Programmer Mode Pin Settings | 655 |
| Table 22.11 | Settings for Each Operating Mode in Programmer Mode | 657 |
| Table 22.12 | Programmer Mode Commands | 657 |
| Table 22.13 | AC Characteristics in Memory Read Mode | 658 |
| Table 22.14 | AC Characteristics when Entering Another Mode from Memory Read Mode | 659 |
| Table 22.15 | AC Characteristics in Memory Read Mode | 660 |
| Table 22.16 | AC Characteristics in Auto-Program Mode | 661 |
| Table 22.17 | AC Characteristics in Auto-Erase Mode | 663 |
| Table 22.18 | AC Characteristics in Status Read Mode | 664 |
| Table 22.19 | Status Read Mode Return Commands..... | 665 |
| Table 22.20 | Status Polling Output Truth Table..... | 666 |
| Table 22.21 | Command Wait State Transition Time Specifications | 666 |
| Table 22.22 | Registers Present in F-ZTAT Version but Absent in Mask ROM Version | 668 |
| | | |
| Section 23 | Clock Pulse Generator | |
| Table 23.1 | CPG Registers | 670 |
| Table 23.2 | Damping Resistance Value | 672 |
| Table 23.3 | Crystal Resonator Parameters | 673 |
| Table 23.4 | External Clock Input Conditions..... | 675 |
| Table 23.5 | External Clock Output Settling Delay Time..... | 676 |
| Table 23.6 | Subclock Input Conditions | 677 |
| | | |
| Section 24 | Power-Down State | |
| Table 24.1 | H8S/2138 Group and H8S/2134 Group Internal States in Each Mode | 682 |
| Table 24.2 | Power-Down Mode Transition Conditions..... | 684 |

| | | |
|-------------------|--|-----|
| Table 24.3 | Power-Down State Registers..... | 685 |
| Table 24.4 | MSTP Bits and Corresponding On-Chip Supporting Modules | 694 |
| Table 24.5 | Oscillation Settling Time Settings..... | 696 |
| | | |
| Section 25 | Electrical Characteristics | |
| Table 25.1 | Power Supply Voltage and Operating Range (1) (F-ZTAT Products) | 703 |
| Table 25.1 | Power Supply Voltage and Operating Range (2) (F-ZTAT A-Mask Products) | 704 |
| Table 25.1 | Power Supply Voltage and Operating Range (3) (Mask-ROM Products)..... | 704 |
| Table 25.1 | Power Supply Voltage and Operating Range (4) (Mask-ROM Products)..... | 705 |
| Table 25.2 | Absolute Maximum Ratings..... | 706 |
| Table 25.3 | DC Characteristics (1)..... | 707 |
| Table 25.3 | DC Characteristics (2)..... | 710 |
| Table 25.3 | DC Characteristics (3)..... | 713 |
| Table 25.4 | Permissible Output Currents | 716 |
| Table 25.5 | Bus Drive Characteristics | 718 |
| Table 25.6 | Clock Timing | 719 |
| Table 25.7 | Control Signal Timing..... | 720 |
| Table 25.8 | Bus Timing..... | 721 |
| Table 25.9 | Timing of On-Chip Supporting Modules (1)..... | 723 |
| Table 25.9 | Timing of On-Chip Supporting Modules (2)..... | 725 |
| Table 25.10 | I ² C Bus Timing..... | 726 |
| Table 25.11 | A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion) | 727 |
| Table 25.12 | A/D Conversion Characteristics (CIN7 to CIN0 Input: 134/266-State Conversion) | 728 |
| Table 25.13 | D/A Conversion Characteristics | 729 |
| Table 25.14 | Flash Memory Characteristics (Programming/Erasing Operating Range)..... | 730 |
| Table 25.15 | Absolute Maximum Ratings..... | 733 |
| Table 25.16 | DC Characteristics (1)..... | 734 |
| Table 25.16 | DC Characteristics (2)..... | 737 |
| Table 25.16 | DC Characteristics (3)..... | 740 |
| Table 25.17 | Permissible Output Currents | 743 |
| Table 25.18 | Bus Drive Characteristics | 744 |
| Table 25.19 | Clock Timing | 745 |
| Table 25.20 | Control Signal Timing..... | 746 |
| Table 25.21 | Bus Timing..... | 747 |
| Table 25.22 | Timing of On-Chip Supporting Modules (1)..... | 749 |
| Table 25.22 | Timing of On-Chip Supporting Modules (2)..... | 751 |
| Table 25.23 | I ² C Bus Timing..... | 752 |
| Table 25.24 | A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion) | 753 |

| | | |
|-------------|--|-----|
| Table 25.25 | A/D Conversion Characteristics (CIN7 to CIN0 Input: 134/266-State Conversion) | 754 |
| Table 25.26 | D/A Conversion Characteristics | 755 |
| Table 25.27 | Flash Memory Characteristics (Programming/Erasing Operating Range) | 756 |
| Table 25.28 | Absolute Maximum Ratings | 759 |
| Table 25.29 | DC Characteristics (1) | 760 |
| Table 25.29 | DC Characteristics (2) | 762 |
| Table 25.29 | DC Characteristics (3) | 765 |
| Table 25.30 | Permissible Output Currents | 768 |
| Table 25.31 | Clock Timing | 769 |
| Table 25.32 | Control Signal Timing | 770 |
| Table 25.33 | Bus Timing | 771 |
| Table 25.34 | Timing of On-Chip Supporting Modules | 773 |
| Table 25.35 | A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion) | 775 |
| Table 25.36 | A/D Conversion Characteristics (CIN7 to CIN0 Input: 134/266-State Conversion) | 776 |
| Table 25.37 | D/A Conversion Characteristics | 777 |
| Table 25.38 | Flash Memory Characteristics | 778 |
| Table 25.39 | Absolute Maximum Ratings | 780 |
| Table 25.40 | DC Characteristics (1) | 781 |
| Table 25.40 | DC Characteristics (2) | 783 |
| Table 25.40 | DC Characteristics (3) | 785 |
| Table 25.41 | Permissible Output Currents | 787 |
| Table 25.42 | Clock Timing | 788 |
| Table 25.43 | Control Signal Timing | 789 |
| Table 25.44 | Bus Timing | 790 |
| Table 25.45 | Timing of On-Chip Supporting Modules | 792 |
| Table 25.46 | A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion) | 794 |
| Table 25.47 | A/D Conversion Characteristics (CIN7 to CIN0 Input: 134/266-State Conversion) | 795 |
| Table 25.48 | D/A Conversion Characteristics | 796 |
| Table 25.49 | Flash Memory Characteristics (Programming/Erasing Operating Range) | 797 |

Appendix A Instruction Set

| | | |
|-----------|------------------------------|-----|
| Table A.1 | Instruction Set | 815 |
| Table A.2 | Instruction Codes | 831 |
| Table A.3 | Operation Code Map (1) | 845 |
| Table A.3 | Operation Code Map (2) | 846 |
| Table A.3 | Operation Code Map (3) | 847 |

| | | |
|-----------|--|-----|
| Table A.3 | Operation Code Map (4) | 848 |
| Table A.4 | Number of States per Cycle..... | 850 |
| Table A.5 | Number of Cycles per Instruction | 851 |
| Table A.6 | Instruction Execution Cycle | 864 |

Appendix D Pin States

| | | |
|-----------|--|-----|
| Table D.1 | I/O Port States in Each Processing State | 997 |
|-----------|--|-----|

Appendix F Product Code Lineup

| | | |
|-----------|--|------|
| Table F.1 | H8S/2138 Group and H8S/2134 Group Product Code Lineup..... | 1000 |
|-----------|--|------|

Section 1 Overview

1.1 Overview

The H8S/2138 Group and H8S/2134 Group comprise microcomputers (MCUs) built around the H8S/2000 CPU, employing Renesas Technology proprietary architecture, and equipped with supporting modules on-chip.

The H8S/2000 CPU has an internal 32-bit architecture, is provided with sixteen 16-bit general registers and a concise, optimized instruction set designed for high-speed operation, and can address a 16-Mbyte linear address space. The instruction set is upward-compatible with H8/300 and H8/300H CPU instructions at the object-code level, facilitating migration from the H8/300, H8/300L, or H8/300H Series.

On-chip supporting modules required for system configuration include a data transfer controller (DTC) bus master, ROM and RAM, a 16-bit free-running timer module (FRT), 8-bit timer module (TMR), watchdog timer module (WDT), two PWM timers (PWM and PWMX), serial communication interface (SCI), host interface (HIF), D/A converter (DAC), A/D converter (ADC), and I/O ports. An I²C bus interface (IIC) can also be incorporated as an option.

The on-chip ROM is either flash memory (F-ZTAT^{TM*}) or mask ROM, with a capacity of 128, 96, 64, or 32 kbytes. ROM is connected to the CPU via a 16-bit data bus, enabling both byte and word data to be accessed in one state. Instruction fetching has been speeded up, and processing speed increased.

Three operating modes, modes 1 to 3, are provided, and there is a choice of address space and single-chip mode or externally expanded modes.

The features of the H8S/2138 Group and H8S/2134 Group are shown in table 1.1.

Note: * F-ZTAT is a trademark of Renesas Technology Corp.

Table 1.1 Overview

| Item | Specifications |
|------|---|
| CPU | <ul style="list-style-type: none"> • General-register architecture <ul style="list-style-type: none"> — Sixteen 16-bit general registers (also usable as sixteen 8-bit registers or eight 32-bit registers) • High-speed operation suitable for real-time control <ul style="list-style-type: none"> — Maximum operating frequency: 20 MHz/5 V, 10 MHz/3 V — High-speed arithmetic operations <ul style="list-style-type: none"> 8/16/32-bit register-register add/subtract: 50 ns (20-MHz operation) 16 × 16-bit register-register multiply: 1000 ns (20-MHz operation) 32 ÷ 16-bit register-register divide: 1000 ns (20-MHz operation) • Instruction set suitable for high-speed operation <ul style="list-style-type: none"> — Sixty-five basic instructions — 8/16/32-bit transfer/arithmetic and logic instructions — Unsigned/signed multiply and divide instructions — Powerful bit-manipulation instructions • Two CPU operating modes <ul style="list-style-type: none"> — Normal mode: 64-kbyte address space — Advanced mode: 16-Mbyte address space |

Operating modes

- Three MCU operating modes

| Mode | CPU Operating Mode | Description | On-Chip ROM | External Data Bus | |
|------|--------------------|---|-------------|-------------------|---------------|
| | | | | Initial Value | Maximum Value |
| 1 | Normal | Expanded mode with on-chip ROM disabled | Disabled | 8 bits | 8 bits |
| 2 | Advanced | Expanded mode with on-chip ROM enabled | Enabled | 8 bits | 8 bits |
| | | Single-chip mode | | None | |
| 3 | Normal | Expanded mode with on-chip ROM enabled | Enabled | 8 bits | 8 bits |
| | | Single-chip mode | | None | |

| Item | Specifications |
|--|--|
| Bus controller | <ul style="list-style-type: none"> • 2-state or 3-state access space can be designated for external expansion areas • Number of program wait states can be set for external expansion areas |
| Data transfer controller (DTC) (H8S/2138 Group) | <ul style="list-style-type: none"> • Can be activated by internal interrupt or software • Multiple transfers or multiple types of transfer possible for one activation source • Transfer possible in repeat mode, block transfer mode, etc. • Request can be sent to CPU for interrupt that activated DTC |
| 16-bit free-running timer module (FRT: 1 channel) | <ul style="list-style-type: none"> • One 16-bit free-running counter (also usable for external event counting) • Two output compare outputs • Four input capture inputs (with buffer operation capability) |
| 8-bit timer module (2 channels: TMR0, TMR1) | <p>Each channel has:</p> <ul style="list-style-type: none"> • One 8-bit up-counter (also usable for external event counting) • Two time constant registers • The two channels can be connected |
| Timer connection and 8-bit timer (TMR) module (2 channels: TMRX, TMRY) (Timer connection and TMRX provided in H8S/2138 Group) | <p>Input/output and FRT, TMR1, TMRX, TMRY can be interconnected</p> <ul style="list-style-type: none"> • Measurement of input signal or frequency-divided waveform pulse width and cycle (FRT, TMR1) • Output of waveform obtained by modification of input signal edge (FRT, TMR1) • Determination of input signal duty cycle (TMRX) • Output of waveform synchronized with input signal (FRT, TMRX, TMRY) • Automatic generation of cyclical waveform (FRT, TMRY) |
| Watchdog timer module (WDT: 2 channels) | <ul style="list-style-type: none"> • Watchdog timer or interval timer function selectable • Subclock operation capability (channel 1 only) |
| 8-bit PWM timer (PWM) (H8S/2138 Group) | <ul style="list-style-type: none"> • Up to 16 outputs • Pulse duty cycle settable from 0 to 100% • Resolution: 1/256 • 1.25 MHz maximum carrier frequency (20-MHz operation) |

| Item | Specifications |
|---|---|
| 14-bit PWM timer (PWMX) | <ul style="list-style-type: none">• Up to 2 outputs• Resolution: 1/16384• 312.5 kHz maximum carrier frequency (20-MHz operation) |
| Serial communication interface (SCI: 2 channels, SCI0 and SCI1) | <ul style="list-style-type: none">• Asynchronous mode or synchronous mode selectable• Multiprocessor communication function |
| SCI with IrDA: 1 channel (SCI2) | <ul style="list-style-type: none">• Asynchronous mode or synchronous mode selectable• Multiprocessor communication function• Compatible with IrDA specification version 1.0• TxD and RxD encoding/decoding in IrDA format |
| Host interface (HIF) (H8S/2138 Group) | <ul style="list-style-type: none">• 8-bit host interface (ISA) port• Three host interrupt requests (HIRQ11, HIRQ1, HIRQ12)• Normal and fast A20 gate output• Two register sets (each comprising two data registers and two status registers) |
| Keyboard controller | <ul style="list-style-type: none">• Matrix keyboard control using keyboard scan with wakeup interrupt and sense port configuration |
| A/D converter | <ul style="list-style-type: none">• Resolution: 10 bits• Input:<ul style="list-style-type: none">— 8 channels (dedicated analog pins)— 8 channels (same pins as keyboard sense port)• High-speed conversion: 6.7 μs minimum conversion time (20-MHz operation)• Single or scan mode selectable• Sample-and-hold function• A/D conversion can be activated by external trigger or timer trigger |
| D/A converter | <ul style="list-style-type: none">• Resolution: 8 bits• Output: 2 channels |
| I/O ports | <ul style="list-style-type: none">• 58 input/output pins (including 24 with LED drive capability)• 8 input-only pins |

| Item | Specifications | | | | | | | | | | | | | | | |
|--|---|--------------|----------|-----|--------------------|------------|----------|----------|-----------|----------|--------------------|-----------|----------|----------|-----------|----------|
| Memory | <ul style="list-style-type: none"> Flash memory or mask ROM High-speed static RAM | | | | | | | | | | | | | | | |
| | <table border="1"> <thead> <tr> <th>Product Name</th> <th>ROM</th> <th>RAM</th> </tr> </thead> <tbody> <tr> <td>H8S/2134, H8S/2138</td> <td>128 kbytes</td> <td>4 kbytes</td> </tr> <tr> <td>H8S/2133</td> <td>96 kbytes</td> <td>4 kbytes</td> </tr> <tr> <td>H8S/2132, H8S/2137</td> <td>64 kbytes</td> <td>2 kbytes</td> </tr> <tr> <td>H8S/2130</td> <td>32 kbytes</td> <td>2 kbytes</td> </tr> </tbody> </table> | Product Name | ROM | RAM | H8S/2134, H8S/2138 | 128 kbytes | 4 kbytes | H8S/2133 | 96 kbytes | 4 kbytes | H8S/2132, H8S/2137 | 64 kbytes | 2 kbytes | H8S/2130 | 32 kbytes | 2 kbytes |
| | Product Name | ROM | RAM | | | | | | | | | | | | | |
| | H8S/2134, H8S/2138 | 128 kbytes | 4 kbytes | | | | | | | | | | | | | |
| | H8S/2133 | 96 kbytes | 4 kbytes | | | | | | | | | | | | | |
| H8S/2132, H8S/2137 | 64 kbytes | 2 kbytes | | | | | | | | | | | | | | |
| H8S/2130 | 32 kbytes | 2 kbytes | | | | | | | | | | | | | | |
| Interrupt controller | <ul style="list-style-type: none"> Nine external interrupt pins (NMI, $\overline{IRQ0}$ to $\overline{IRQ7}$) 39 internal interrupt sources Three priority levels settable | | | | | | | | | | | | | | | |
| Power-down state | <ul style="list-style-type: none"> Medium-speed mode Sleep mode Module stop mode Software standby mode Hardware standby mode Subclock operation | | | | | | | | | | | | | | | |
| Clock pulse generator | <ul style="list-style-type: none"> On-chip duty correction circuit | | | | | | | | | | | | | | | |
| Packages | <ul style="list-style-type: none"> 80-pin plastic QFP (FP-80A) 80-pin plastic TQFP (TFP-80C) | | | | | | | | | | | | | | | |
| I ² C bus interface (IIC: 2 channels) (option in H8S/2138 Group) | <ul style="list-style-type: none"> Conforms to Philips I²C bus interface standard Single master mode/slave mode Arbitration lost condition can be identified Supports two slave addresses | | | | | | | | | | | | | | | |

| Item | Specifications | | | |
|--|----------------------------|-------------------------|---------------------|--------------------|
| Product lineup (preliminary) | Product Code ^{*3} | | | |
| | Group | Mask ROM Versions | F-ZTAT™ Versions | ROM/RAM (Bytes) |
| H8S/2138 | HD6432138S | HD64F2138 ^{*2} | 128 k/4 k | FP-80A, TFP-80C |
| | HD6432138SW ^{*1} | HD64F2138A | | |
| | HD6432137S | — | 64 k/2 k | |
| | HD6432137SW ^{*1} | | | |
| H8S/2134 | HD6432134S | HD64F2134 HD64F2134A | 128 k/4 k | |
| | HD6432133S | — | | 96 k/4 k |
| | HD6432132 | HD64F2132R | 64 k/2 k | |
| | HD6432130 | — | | 32 k/2 k |
| Notes: 1. "W" indicates the I ² C bus option. 2. FP-80A only 3. For the 3-V version, "V" is added to the product code. See appendix F, Product Code Lineup. | | | | |

1.2 Internal Block Diagram

An internal block diagram of the H8S/2138 Group is shown in figure 1.1, and an internal block diagram of the H8S/2134 Group in figure 1.2.

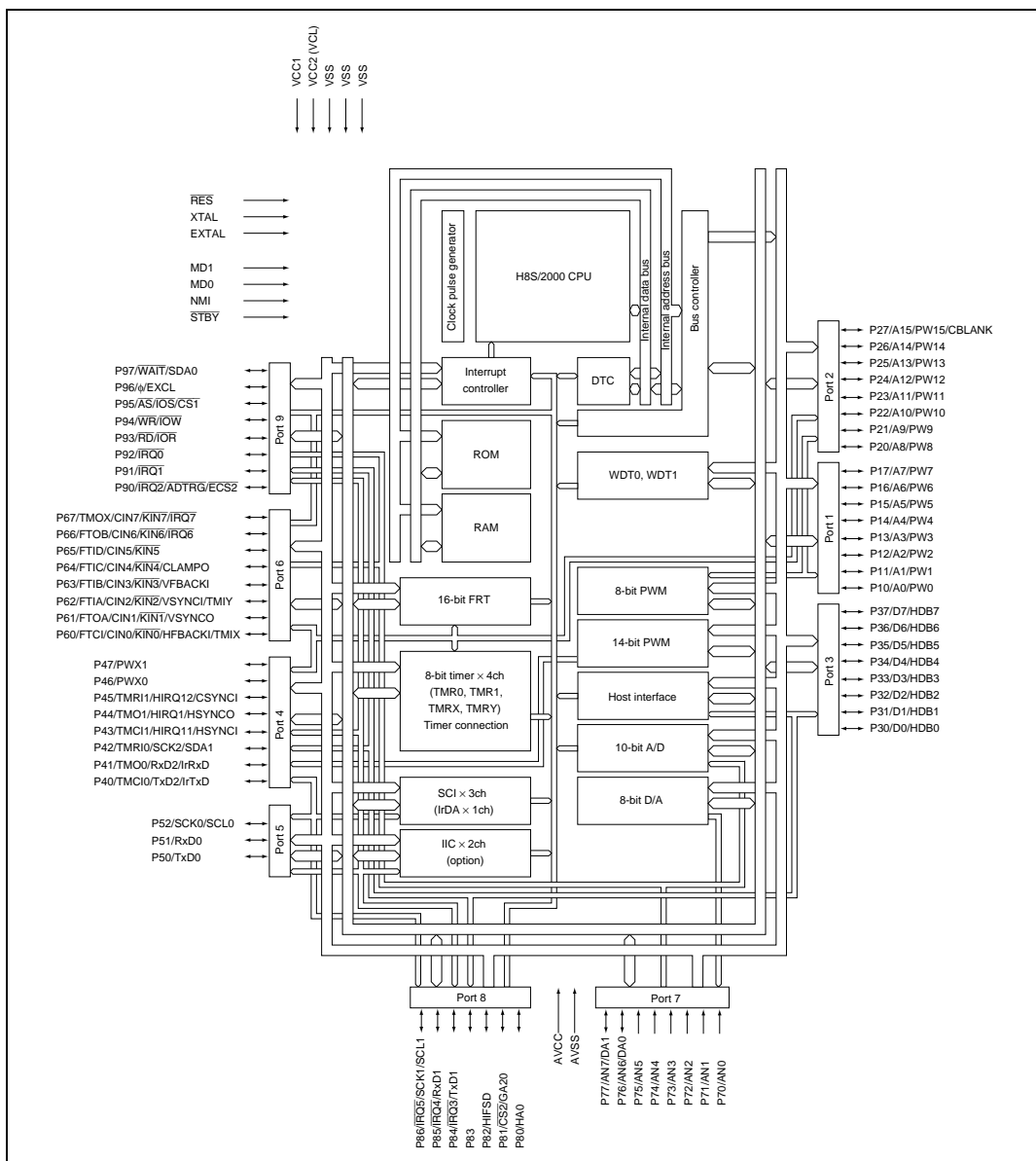


Figure 1.1 Internal Block Diagram of H8S/2138 Group

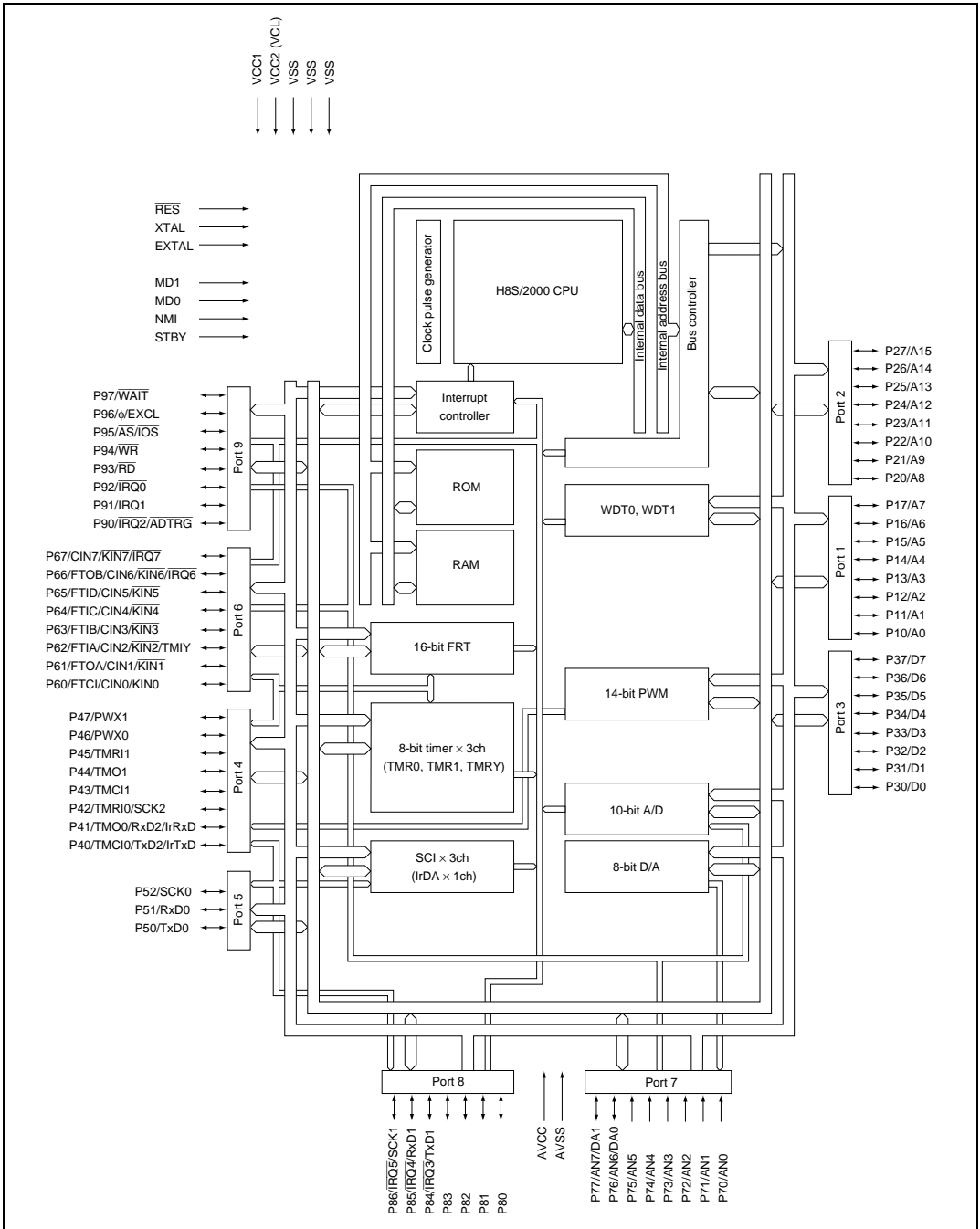


Figure 1.2 Internal Block Diagram of H8S/2134 Group

1.3 Pin Arrangement and Functions

1.3.1 Pin Arrangement

The pin arrangement of the H8S/2138 Group is shown in figure 1.3, and the pin arrangement of the H8S/2134 Group in figure 1.4.

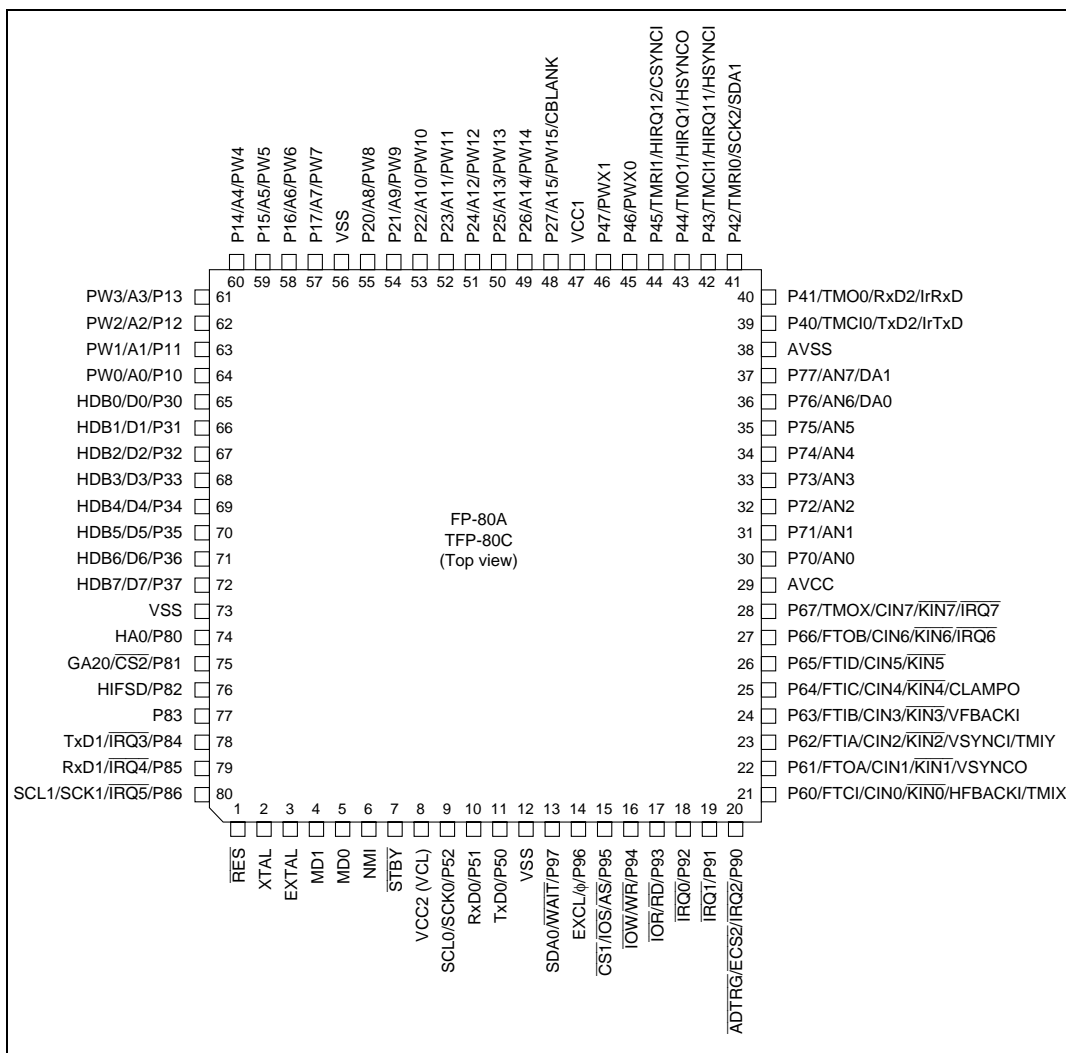


Figure 1.3 Pin Arrangement of H8S/2138 Group (FP-80A, TFP-80C: Top View)

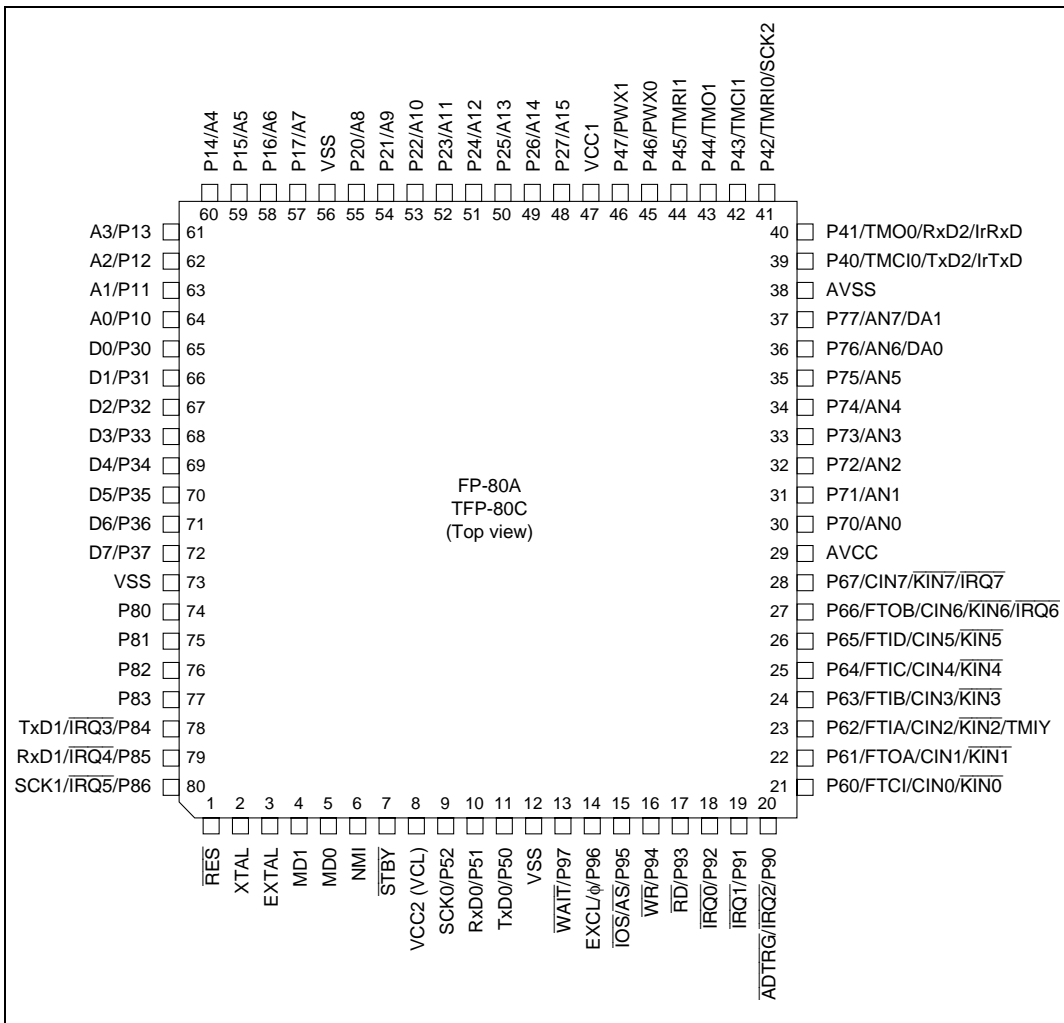


Figure 1.4 Pin Arrangement of H8S/2134 Group (FP-80A, TFP-80C: Top View)

1.3.2 Pin Functions in Each Operating Mode

Tables 1.2 and 1.3 show the pin functions of the H8S/2138 Group and H8S/2134 Group in each of the operating modes.

Table 1.2 H8S/2138 Group Pin Functions in Each Operating Mode

| Pin No. | Pin Name | | | Flash Memory Programmer Mode |
|-------------------|---|---|---|------------------------------|
| | Expanded Modes | Single-Chip Modes | | |
| FP-80A TFP-80C | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | |
| 1 | RES | RES | RES | RES |
| 2 | XTAL | XTAL | XTAL | XTAL |
| 3 | EXTAL | EXTAL | EXTAL | EXTAL |
| 4 | MD1 | MD1 | MD1 | VSS |
| 5 | MD0 | MD0 | MD0 | VSS |
| 6 | NMI | NMI | NMI | FA9 |
| 7 | STBY | STBY | STBY | VCC |
| 8 | VCC2 (VCL) | VCC2 (VCL) | VCC2 (VCL) | VCC |
| 9 | P52/SCK0/SCL0 | P52/SCK0/SCL0 | P52/SCK0/SCL0 | NC |
| 10 | P51/RxD0 | P51/RxD0 | P51/RxD0 | FA17 |
| 11 | P50/TxD0 | P50/TxD0 | P50/TxD0 | NC |
| 12 | VSS | VSS | VSS | VSS |
| 13 | P97/WAIT/SDA0 | P97/WAIT/SDA0 | P97/SDA0 | VCC |
| 14 | ϕ /P96/EXCL | ϕ /P96/EXCL | P96/ ϕ /EXCL | NC |
| 15 | AS/IOS | AS/IOS | P95/CS1 | FA16 |
| 16 | WR | WR | P94/IOW | FA15 |
| 17 | RD | RD | P93/IOR | WE |
| 18 | P92/IRQ0 | P92/IRQ0 | P92/IRQ0 | VSS |
| 19 | P91/IRQ1 | P91/IRQ1 | P91/IRQ1 | VCC |
| 20 | P90/IRQ2/ ADTRG | P90/IRQ2/ADTRG | P90/IRQ2/ADTRG/ ECS2 | VCC |
| 21 | P60/FTCI/CIN0/ KIN0/TMIX/ HFBACKI | P60/FTCI/CIN0/ KIN0/TMIX/ HFBACKI | P60/FTCI/CIN0/ KIN0/TMIX/ HFBACKI | NC |
| 22 | P61/FTOA/CIN1/ KIN1/VSYNCO | P61/FTOA/CIN1/ KIN1/VSYNCO | P61/FTOA/CIN1/ KIN1/VSYNCO | NC |

Pin Name

| Pin No. | Expanded Modes | | Single-Chip Modes | Flash Memory Programmer Mode |
|---------|--|--|--|------------------------------|
| | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | |
| 23 | P62/FTIA/CIN2/ KIN2/TMIY/ VSYNCI | P62/FTIA/CIN2/ KIN2/TMIY/ VSYNCI | P62/FTIA/CIN2/ KIN2/TMIY/ VSYNCI | NC |
| 24 | P63/FTIB/CIN3/ KIN3/VFBACKI | P63/FTIB/CIN3/ KIN3/VFBACKI | P63/FTIB/CIN3/ KIN3/VFBACKI | NC |
| 25 | P64/FTIC/CIN4/ KIN4/CLAMPO | P64/FTIC/CIN4/ KIN4/CLAMPO | P64/FTIC/CIN4/ KIN4/CLAMPO | NC |
| 26 | P65/FTID/CIN5/ KIN5 | P65/FTID/CIN5/ KIN5 | P65/FTID/CIN5/ KIN5 | NC |
| 27 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | NC |
| 28 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | VSS |
| 29 | AVCC | AVCC | AVCC | VCC |
| 30 | P70/AN0 | P70/AN0 | P70/AN0 | NC |
| 31 | P71/AN1 | P71/AN1 | P71/AN1 | NC |
| 32 | P72/AN2 | P72/AN2 | P72/AN2 | NC |
| 33 | P73/AN3 | P73/AN3 | P73/AN3 | NC |
| 34 | P74/AN4 | P74/AN4 | P74/AN4 | NC |
| 35 | P75/AN5 | P75/AN5 | P75/AN5 | NC |
| 36 | P76/AN6/DA0 | P76/AN6/DA0 | P76/AN6/DA0 | NC |
| 37 | P77/AN7/DA1 | P77/AN7/DA1 | P77/AN7/DA1 | NC |
| 38 | AVSS | AVSS | AVSS | VSS |
| 39 | P40/TMCIO/ TxD2/IrTxD | P40/TMCIO/ TxD2/IrTxD | P40/TMCIO/ TxD2/IrTxD | NC |
| 40 | P41/TMO0/ RxD2/IrRxD | P41/TMO0/ RxD2/IrRxD | P41/TMO0/ RxD2/IrRxD | NC |
| 41 | P42/TMRI0/ SCK2/SDA1 | P42/TMRI0/ SCK2/SDA1 | P42/TMRI0/ SCK2/SDA1 | NC |
| 42 | P43/TMC11/ HSYNCI | P43/TMC11/ HSYNCI | P43/TMC11/ HIRQ11/HSYNCI | NC |
| 43 | P44/TMO1/ HSYNCO | P44/TMO1/ HSYNCO | P44/TMO1/HIRQ1/ HSYNCO | NC |
| 44 | P45/TMRI1/ CSYNCI | P45/TMRI1/ CSYNCI | P45/TMRI1/ HIRQ12/CSYNCI | NC |

| Pin No. | Pin Name | | | Flash Memory Programmer Mode |
|-------------------|----------------|--|--|------------------------------|
| | Expanded Modes | Single-Chip Modes | | |
| FP-80A TFP-80C | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | |
| 45 | P46/PWX0 | P46/PWX0 | P46/PWX0 | NC |
| 46 | P47/PWX1 | P47/PWX1 | P47/PWX1 | NC |
| 47 | VCC1 | VCC1 | VCC1 | VCC |
| 48 | A15 | A15/P27/PW15/ CBLANK | P27/PW15/ CBLANK | \overline{CE} |
| 49 | A14 | A14/P26/PW14 | P26/PW14 | FA14 |
| 50 | A13 | A13/P25/PW13 | P25/PW13 | FA13 |
| 51 | A12 | A12/P24/PW12 | P24/PW12 | FA12 |
| 52 | A11 | A11/P23/PW11 | P23/PW11 | FA11 |
| 53 | A10 | A10/P22/PW10 | P22/PW10 | FA10 |
| 54 | A9 | A9/P21/PW9 | P21/PW9 | \overline{OE} |
| 55 | A8 | A8/P20/PW8 | P20/PW8 | FA8 |
| 56 | VSS | VSS | VSS | VSS |
| 57 | A7 | A7/P17/PW7 | P17/PW7 | FA7 |
| 58 | A6 | A6/P16/PW6 | P16/PW6 | FA6 |
| 59 | A5 | A5/P15/PW5 | P15/PW5 | FA5 |
| 60 | A4 | A4/P14/PW4 | P14/PW4 | FA4 |
| 61 | A3 | A3/P13/PW3 | P13/PW3 | FA3 |
| 62 | A2 | A2/P12/PW2 | P12/PW2 | FA2 |
| 63 | A1 | A1/P11/PW1 | P11/PW1 | FA1 |
| 64 | A0 | A0/P10/PW0 | P10/PW0 | FA0 |
| 65 | D0 | D0 | P30/HDB0 | FO0 |
| 66 | D1 | D1 | P31/HDB1 | FO1 |
| 67 | D2 | D2 | P32/HDB2 | FO2 |
| 68 | D3 | D3 | P33/HDB3 | FO3 |
| 69 | D4 | D4 | P34/HDB4 | FO4 |
| 70 | D5 | D5 | P35/HDB5 | FO5 |
| 71 | D6 | D6 | P36/HDB6 | FO6 |
| 72 | D7 | D7 | P37/HDB7 | FO7 |
| 73 | VSS | VSS | VSS | VSS |
| 74 | P80 | P80 | P80/HA0 | NC |

| Pin No. | Pin Name | | | | |
|-------------------|--|--|--|--|------------------------------|
| | Expanded Modes | | Single-Chip Modes | | Flash Memory Programmer Mode |
| FP-80A TFP-80C | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | | |
| 75 | P81 | P81 | P81/CS2/GA20 | | NC |
| 76 | P82 | P82 | P82/HIFSD | | NC |
| 77 | P83 | P83 | P83 | | NC |
| 78 | P84/ $\overline{\text{IRQ3}}$ /TxD1 | P84/ $\overline{\text{IRQ3}}$ /TxD1 | P84/ $\overline{\text{IRQ3}}$ /TxD1 | | NC |
| 79 | P85/ $\overline{\text{IRQ4}}$ /RxD1 | P85/ $\overline{\text{IRQ4}}$ /RxD1 | P85/ $\overline{\text{IRQ4}}$ /RxD1 | | NC |
| 80 | P86/ $\overline{\text{IRQ5}}$ /SCK1/ SCL1 | P86/ $\overline{\text{IRQ5}}$ /SCK1/ SCL1 | P86/ $\overline{\text{IRQ5}}$ /SCK1/ SCL1 | | NC |

Table 1.3 H8S/2134 Group Pin Functions in Each Operating Mode

| Pin No. | Pin Name | | | Flash Memory Programmer Mode |
|-------------------|--|--|--|------------------------------|
| | Expanded Modes | Single-Chip Modes | | |
| FP-80A TFP-80C | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | |
| 1 | $\overline{\text{RES}}$ | $\overline{\text{RES}}$ | $\overline{\text{RES}}$ | $\overline{\text{RES}}$ |
| 2 | XTAL | XTAL | XTAL | XTAL |
| 3 | EXTAL | EXTAL | EXTAL | EXTAL |
| 4 | MD1 | MD1 | MD1 | VSS |
| 5 | MD0 | MD0 | MD0 | VSS |
| 6 | NMI | NMI | NMI | FA9 |
| 7 | $\overline{\text{STBY}}$ | $\overline{\text{STBY}}$ | $\overline{\text{STBY}}$ | VCC |
| 8 | VCC2 (VCL) | VCC2 (VCL) | VCC2 (VCL) | VCC |
| 9 | P52/SCK0 | P52/SCK0 | P52/SCK0 | NC |
| 10 | P51/RxD0 | P51/RxD0 | P51/RxD0 | FA17 |
| 11 | P50/TxD0 | P50/TxD0 | P50/TxD0 | NC |
| 12 | VSS | VSS | VSS | VSS |
| 13 | P97/ $\overline{\text{WAIT}}$ | P97/ $\overline{\text{WAIT}}$ | P97 | VCC |
| 14 | ϕ /P96/EXCL | ϕ /P96/EXCL | ϕ /P96/EXCL | NC |
| 15 | $\overline{\text{AS}}/\overline{\text{IOS}}$ | $\overline{\text{AS}}/\overline{\text{IOS}}$ | P95 | FA16 |
| 16 | $\overline{\text{WR}}$ | $\overline{\text{WR}}$ | P94 | FA15 |
| 17 | $\overline{\text{RD}}$ | $\overline{\text{RD}}$ | P93 | $\overline{\text{WE}}$ |
| 18 | P92/ $\overline{\text{IRQ0}}$ | P92/ $\overline{\text{IRQ0}}$ | P92/ $\overline{\text{IRQ0}}$ | VSS |
| 19 | P91/ $\overline{\text{IRQ1}}$ | P91/ $\overline{\text{IRQ1}}$ | P91/ $\overline{\text{IRQ1}}$ | VCC |
| 20 | P90/ $\overline{\text{IRQ2/ADTRG}}$ | P90/ $\overline{\text{IRQ2/ADTRG}}$ | P90/ $\overline{\text{IRQ2/ADTRG}}$ | VCC |
| 21 | P60/FTCI/CIN0/ KIN0 | P60/FTCI/CIN0/ KIN0 | P60/FTCI/CIN0/ KIN0 | NC |
| 22 | P61/FTOA/CIN1/ KIN1 | P61/FTOA/CIN1/ KIN1 | P61/FTOA/CIN1/ KIN1 | NC |
| 23 | P62/FTIA/CIN2/ KIN2/TMIY | P62/FTIA/CIN2/ KIN2/TMIY | P62/FTIA/CIN2/ KIN2/TMIY | NC |
| 24 | P63/FTIB/CIN3/ KIN3 | P63/FTIB/CIN3/ KIN3 | P63/FTIB/CIN3/ KIN3 | NC |
| 25 | P64/FTIC/CIN4/ KIN4 | P64/FTIC/CIN4/ KIN4 | P64/FTIC/CIN4/ KIN4 | NC |

Pin Name

| Pin No. | Expanded Modes | | Single-Chip Modes | Flash Memory Programmer Mode |
|---------|-----------------------------|--|--|------------------------------|
| | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | |
| 26 | P65/FTID/CIN5/ KIN5 | P65/FTID/CIN5/ KIN5 | P65/FTID/CIN5/ KIN5 | NC |
| 27 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | NC |
| 28 | P67/CIN7/KIN7/ IRQ7 | P67/CIN7/KIN7/ IRQ7 | P67/CIN7/KIN7/ IRQ7 | VSS |
| 29 | AVCC | AVCC | AVCC | VCC |
| 30 | P70/AN0 | P70/AN0 | P70/AN0 | NC |
| 31 | P71/AN1 | P71/AN1 | P71/AN1 | NC |
| 32 | P72/AN2 | P72/AN2 | P72/AN2 | NC |
| 33 | P73/AN3 | P73/AN3 | P73/AN3 | NC |
| 34 | P74/AN4 | P74/AN4 | P74/AN4 | NC |
| 35 | P75/AN5 | P75/AN5 | P75/AN5 | NC |
| 36 | P76/AN6/DA0 | P76/AN6/DA0 | P76/AN6/DA0 | NC |
| 37 | P77/AN7/DA1 | P77/AN7/DA1 | P77/AN7/DA1 | NC |
| 38 | AVSS | AVSS | AVSS | VSS |
| 39 | P40/TMCIO/ TxD2/IrTxD | P40/TMCIO/ TxD2/IrTxD | P40/TMCIO/ TxD2/IrTxD | NC |
| 40 | P41/TMO0/ RxD2/IrRxD | P41/TMO0/ RxD2/IrRxD | P41/TMO0/ RxD2/IrRxD | NC |
| 41 | P42/TMRI0/ SCK2 | P42/TMRI0/ SCK2 | P42/TMRI0/ SCK2 | NC |
| 42 | P43/TMC11 | P43/TMC11 | P43/TMC11 | NC |
| 43 | P44/TMO1 | P44/TMO1 | P44/TMO1 | NC |
| 44 | P45/TMRI1 | P45/TMRI1 | P45/TMRI1 | NC |
| 45 | P46/PWX0 | P46/PWX0 | P46/PWX0 | NC |
| 46 | P47/PWX1 | P47/PWX1 | P47/PWX1 | NC |
| 47 | VCC1 | VCC1 | VCC1 | VCC |
| 48 | A15 | A15/P27 | P27 | \overline{CE} |
| 49 | A14 | A14/P26 | P26 | FA14 |
| 50 | A13 | A13/P25 | P25 | FA13 |
| 51 | A12 | A12/P24 | P24 | FA12 |
| 52 | A11 | A11/P23 | P23 | FA11 |

| Pin No. | Pin Name | | | |
|-------------------|------------------------------|--|--|------------------------------|
| | Expanded Modes | | Single-Chip Modes | Flash Memory Programmer Mode |
| FP-80A TFP-80C | Mode 1 | Mode 2 (EXPE = 1) Mode 3 (EXPE = 1) | Mode 2 (EXPE = 0) Mode 3 (EXPE = 0) | |
| 53 | A10 | A10/P22 | P22 | FA10 |
| 54 | A9 | A9/P21 | P21 | \overline{OE} |
| 55 | A8 | A8/P20 | P20 | FA8 |
| 56 | VSS | VSS | VSS | VSS |
| 57 | A7 | A7/P17 | P17 | FA7 |
| 58 | A6 | A6/P16 | P16 | FA6 |
| 59 | A5 | A5/P15 | P15 | FA5 |
| 60 | A4 | A4/P14 | P14 | FA4 |
| 61 | A3 | A3/P13 | P13 | FA3 |
| 62 | A2 | A2/P12 | P12 | FA2 |
| 63 | A1 | A1/P11 | P11 | FA1 |
| 64 | A0 | A0/P10 | P10 | FA0 |
| 65 | D0 | D0 | P30 | FO0 |
| 66 | D1 | D1 | P31 | FO1 |
| 67 | D2 | D2 | P32 | FO2 |
| 68 | D3 | D3 | P33 | FO3 |
| 69 | D4 | D4 | P34 | FO4 |
| 70 | D5 | D5 | P35 | FO5 |
| 71 | D6 | D6 | P36 | FO6 |
| 72 | D7 | D7 | P37 | FO7 |
| 73 | VSS | VSS | VSS | VSS |
| 74 | P80 | P80 | P80 | NC |
| 75 | P81 | P81 | P81 | NC |
| 76 | P82 | P82 | P82 | NC |
| 77 | P83 | P83 | P83 | NC |
| 78 | P84/ $\overline{IRQ3}$ /TxD1 | P84/ $\overline{IRQ3}$ /TxD1 | P84/ $\overline{IRQ3}$ /TxD1 | NC |
| 79 | P85/ $\overline{IRQ4}$ /RxD1 | P85/ $\overline{IRQ4}$ /RxD1 | P85/ $\overline{IRQ4}$ /RxD1 | NC |
| 80 | P86/ $\overline{IRQ5}$ /SCK1 | P86/ $\overline{IRQ5}$ /SCK1 | P86/ $\overline{IRQ5}$ /SCK1 | NC |

1.3.3 Pin Functions

Table 1.4 summarizes the functions of the H8S/2138 Group and H8S/2134 Group pins.

Table 1.4 Pin Functions

| Type | Symbol | Pin No. | | Name and Function |
|--------------|---------------|-------------------|--------|--|
| | | FP-80A TFP-80C | I/O | |
| Power supply | VCC1, VCC2 | 8*, 47 | Input | Power supply: For connection to the power supply. All VCC1 and VCC2* pins should be connected to the system power supply. |
| | VCL | 8* | Input | Internal step-down voltage pin: A power supply pin for the product, applicable to product lines that have an internal step-down voltage. In the 5-V and 4-V versions, connect external capacitors to stabilize the internal step-down voltage between this pin and the VSS pin. <u>Do not connect it to Vcc.</u> In the 3-V version, connect this pin and the VCC1 pin to the power supply for the system. For details, See Section 25, Electrical Characteristics. |
| | VSS | 12, 56, 73 | Input | Ground: For connection to the power supply (0 V). All VSS pins should be connected to the system power supply (0 V). |
| Clock | XTAL | 2 | Input | Connected to a crystal oscillator. See section 23, Clock Pulse Generator, for typical connection diagrams for a crystal oscillator and external clock input. |
| | EXTAL | 3 | Input | Connected to a crystal oscillator. The EXTAL pin can also input an external clock. See section 23, Clock Pulse Generator, for typical connection diagrams for a crystal oscillator and external clock input. |
| | ϕ | 14 | Output | System clock: Supplies the system clock to external devices. |
| | EXCL | 14 | Input | External subclock input: Input a 32.768 kHz external subclock. |

| Type | Symbol | Pin No. | | I/O | Name and Function |
|------------------------|----------------------------|--------------------|-------------|--------------|--|
| | | FP-80A | TFP-80C | | |
| Operating mode control | MD1 | 4 | | Input | Mode pins: These pins set the operating mode. The relation between the settings of pins MD1 and MD0 and the operating mode is shown below. These pins should not be changed while the MCU is operating. |
| | MD0 | 5 | | | |
| Operating Mode | | | | | |
| | MD1 | MD0 | Mode | | Description |
| | 0 | 1 | Mode 1 | | Normal Expanded mode with on-chip ROM disabled |
| | 1 | 0 | Mode 2 | | Advanced Expanded mode with on-chip ROM enabled or single-chip mode |
| | 1 | 1 | Mode 3 | | Normal Expanded mode with on-chip ROM enabled or single-chip mode |
| System control | $\overline{\text{RES}}$ | 1 | | Input | Reset input: When this pin is driven low, the chip is reset. |
| | $\overline{\text{STBY}}$ | 7 | | Input | Standby: When this pin is driven low, a transition is made to hardware standby mode. |
| Address bus | A15 to A0 | 48 to 55, 57 to 64 | | Output | Address bus: These pins output an address. |
| Data bus | D7 to D0 | 72 to 65 | | Input/output | Data bus (upper): Bidirectional data bus. Used for 8-bit data. |
| Bus control | $\overline{\text{WAIT}}$ | 13 | | Input | Wait: Requests insertion of a wait state in the bus cycle when accessing external 3-state address space. |
| | $\overline{\text{RD}}$ | 17 | | Output | Read: When this pin is low, it indicates that the external address space is being read. |
| | $\overline{\text{WR}}$ | 16 | | Output | Write: When this pin is low, it indicates that the external address space is being written to. |
| | $\overline{\text{AS/IOS}}$ | 15 | | Output | Address strobe: When this pin is low, it indicates that address output on the address bus is valid. |

| Type | Symbol | Pin No. | | I/O | Name and Function |
|---------------------------------------|-----------------|----------------------------------|---------|---|---|
| | | FP-80A | TFP-80C | | |
| Interrupt signals | NMI | 6 | | Input | Nonmaskable interrupt: Requests a nonmaskable interrupt. |
| | IRQ0 to IRQ7 | 18 to 20, 78 to 80, 27, 28 | | Input | Interrupt request 0 to 7: These pins request a maskable interrupt. |
| 16-bit free-running timer (FRT) | FTCI | 21 | | Input | FRT counter clock input: Input pin for an external clock signal for the free-running counter (FRC). |
| | FTOA | 22 | | Output | FRT output compare A output: The output compare A output pin. |
| | FTOB | 27 | | Output | FRT output compare B output: The output compare B output pin. |
| | FTIA | 23 | | Input | FRT input capture A input: The input capture A input pin. |
| | FTIB | 24 | | Input | FRT input capture B input: The input capture B input pin. |
| | FTIC | 25 | | Input | FRT input capture C input: The input capture C input pin. |
| | FTID | 26 | | Input | FRT input capture D input: The input capture D input pin. |
| 8-bit timer (TMR0, TMR1, TMRX, TMR Y) | TMO0 | 40 | | Output | Compare-match output: TMR0, TMR1, and TMRX compare-match output pins. |
| | TMO1 | 43 | | | |
| | TMOX | 28 | | | |
| | TMCI0 | 39 | | Input | Counter external clock input: Input pins for the external clock input to the TMR0 and TMR1 counters. |
| | TMCI1 | 42 | | | |
| | TMRI0 | 41 | | | |
| | TMRI1 | 44 | | | |
| TMIX | 21 | | Input | Counter external clock input and reset input: Dual function as TMRX and TMR Y counter clock input pin and reset input pin. | |
| TMIY | 23 | | | | |
| PWM timer (PWM) | PW15 to PW0 | 48 to 55, 57 to 64 | | Output | PWM timer output: PWM timer pulse output pins. |
| 14-bit PWM timer (PWMX) | PWX0 PWX1 | 45 46 | | Output | PWMX timer output: PWM D/A pulse output pins. |

| Type | Symbol | Pin No. | | I/O | Name and Function |
|---|---|-----------------------|---------|--------------|--|
| | | FP-80A | TFP-80C | | |
| Serial communication interface (SCI0, SCI1, SCI2) | TxD0 | 11 | | Output | Transmit data: Data output pins. |
| | TxD1 | 78 | | | |
| | TxD2 | 39 | | | |
| | RxD0 | 10 | | Input | Receive data: Data input pins. |
| | RxD1 | 79 | | | |
| | RxD2 | 40 | | | |
| | SCK0 | 9 | | Input/output | Serial clock: Clock input/output pins. The SCK0 output type is NMOS push-pull in the H8S/2138 Group and CMOS output in the H8S/2134 Group. |
| | SCK1 | 80 | | | |
| | SCK2 | 41 | | | |
| SCI with IrDA (SCI2) | IrTxD | 39 | | Output | IrDA transmit data/receive data: Input and output pins for data encoded for IrDA use. |
| | IrRxD | 40 | | Input | |
| Host interface (HIF) | HDB7 to HDB0 | 72 to 65 | | Input/output | Host interface data bus: Bidirectional 8-bit bus for accessing the host interface. |
| | $\overline{CS1}$, $\overline{CS2}$, $\overline{ECS2}$ | 15, 75, 20 | | Input | Chip select 1 and 2: Input pins for selecting host interface channel 1 or 2. |
| | \overline{IOR} | 17 | | Input | I/O read: Input pin that enables reading from the host interface. |
| | \overline{IOW} | 16 | | Input | I/O write: Input pin that enables writing to the host interface. |
| | HA0 | 74 | | Input | Command/data: Input pin that indicates whether an access is a data access or command access. |
| | GA20 | 75 | | Output | GATE A20: A20 gate control signal output pin. |
| | HIRQ11 | 42 | | Output | Host interrupt 11, 1, and 12: Output pins for interrupt requests to the host. |
| | HIRQ1 | 43 | | | |
| HIRQ12 | 44 | | | | |
| | HIFSD | 76 | | Input | Host interface shutdown: Control input pin used to place host interface input/output pins in the high-impedance/cutoff state. |
| Keyboard control | $\overline{KIN0}$ to $\overline{KIN7}$ | 21 to 24, 25 to 28 | | Input | Keyboard input: Matrix keyboard input pins. Normally, P10 to P17 and P20 to P27 are used as key-scan outputs. This enables a maximum 16-output × 16-input, 256-key matrix to be configured. |

| Type | Symbol | Pin No. | | I/O | Name and Function |
|---|--|--------------------|---------|--------------|---|
| | | FP-80A | TFP-80C | | |
| A/D converter (ADC) | AN7 to AN0 | 37 to 30 | | Input | Analog input: A/D converter analog input pins. |
| | CN0 to CN7 | 21 to 24, 25 to 28 | | Input | Expansion A/D inputs: Expansion A/D input pins can be connected to the A/D converter, but since they are also used as digital input/output pins, precision will fall. |
| | ADTRG | 20 | | Input | A/D conversion external trigger input: Pin for input of an external trigger to start A/D conversion. |
| D/A converter (DAC) | DA0 DA1 | 36 37 | | Output | Analog output: D/A converter analog output pins. |
| A/D converter | AVCC | 29 | | Input | Analog reference voltage: The analog power supply pin for the A/D converter and D/A converter. When the A/D and D/A converters are not used, this pin should be connected to the system power supply (+5 V or +3 V). |
| D/A converter | AVSS | 38 | | Input | Analog ground: The ground pin for the A/D converter and D/A converter. This pin should be connected to the system power supply (0 V). |
| Timer connection | VSYNCI, HSYNCI, CSYNCI, VFBACKI, HFBACKI | 23, 42, 44, 24, 21 | | Input | Timer connection input: Timer connection synchronous signal input pins. |
| | VSYNCO, HSYNCO, CLAMPO, CBLANK | 22, 43, 25, 48 | | Output | Timer connection output: Timer connection synchronous signal output pins. |
| I ² C bus interface (IIC) (option) | SCL0 SCL1 | 9 80 | | Input/output | I²C clock input/output (channels 0 and 1): I ² C clock I/O pins. These pins have a bus drive function. The SCL0 output form is NMOS open-drain |
| | SDA0 SDA1 | 13 41 | | Input/output | I²C data input/output (channels 0 and 1): I ² C data I/O pins. These pins have a bus drive function. The SDA0 output form is NMOS open-drain. |

| Type | Symbol | Pin No. | | I/O | Name and Function |
|-----------|------------|----------|---------|--------------|--|
| | | FP-80A | TFP-80C | | |
| I/O ports | P17 to P10 | 57 to 64 | | Input/output | Port 1: Eight input/output pins. The data direction of each pin can be selected in the port 1 data direction register (P1DDR). These pins have on-chip MOS input pull-ups, and also have LED drive capability. |
| | P27 to P20 | 48 to 55 | | Input/output | Port 2: Eight input/output pins. The data direction of each pin can be selected in the port 2 data direction register (P2DDR). These pins have on-chip MOS input pull-ups, and also have LED drive capability. |
| | P37 to P30 | 72 to 65 | | Input/output | Port 3: Eight input/output pins. The data direction of each pin can be selected in the port 3 data direction register (P3DDR). These pins have on-chip MOS input pull-ups, and also have LED drive capability. |
| | P47 to P40 | 46 to 39 | | Input/output | Port 4: Eight input/output pins. The data direction of each pin can be selected in the port 4 data direction register (P4DDR). |
| | P52 to P50 | 9 to 11 | | Input/output | Port 5: Three input/output pins. The data direction of each pin can be selected in the port 5 data direction register (P5DDR). P52 is an NMOS push-pull output in the H8S/2138 Group and is a CMOS output in the H8S/2134 Group. |
| | P67 to P60 | 28 to 21 | | Input/output | Port 6: Eight input/output pins. The data direction of each pin can be selected in the port 6 data direction register (P6DDR). These pins have on-chip MOS input pull-ups. |
| | P77 to P70 | 37 to 30 | | Input | Port 7: Eight input pins. |
| | P86 to P80 | 80 to 74 | | Input/output | Port 8: Seven input/output pins. The data direction of each pin can be selected in the port 8 data direction register (P8DDR). |
| | P97 to P90 | 13 to 20 | | Input/output | Port 9: Eight input/output pins. The data direction of each pin (except P96) can be selected in the port 9 data direction register (P9DDR). P97 is an NMOS push-pull output in the H8S/2138 Group and is a CMOS output in the H8S/2134 Group. |

Note: * In F-ZTAT and mask ROM versions of HD64F2138A, HD64F2134A, HD6432138S, HD6432138SW, HD6432137S, HD6432137SW, HD6432134S, and HD6432133S, VCC2 pin (8 pin) is the VCL pin.

Section 2 CPU

2.1 Overview

The H8S/2000 CPU is a high-speed central processing unit with an internal 32-bit architecture that is upward-compatible with the H8/300 and H8/300H CPUs. The H8S/2000 CPU has sixteen 16-bit general registers, can address a 16-Mbyte (architecturally 4-Gbyte) linear address space, and is ideal for realtime control.

2.1.1 Features

The H8S/2000 CPU has the following features.

- Upward-compatible with H8/300 and H8/300H CPUs
 - Can execute H8/300 and H8/300H object programs
- General-register architecture
 - Sixteen 16-bit general registers (also usable as sixteen 8-bit registers or eight 32-bit registers)
- Sixty-five basic instructions
 - 8/16/32-bit arithmetic and logic instructions
 - Multiply and divide instructions
 - Powerful bit-manipulation instructions
- Eight addressing modes
 - Register direct [Rn]
 - Register indirect [@ERn]
 - Register indirect with displacement [@(d:16,ERn) or @(d:32,ERn)]
 - Register indirect with post-increment or pre-decrement [@ERn+ or @-ERn]
 - Absolute address [@aa:8, @aa:16, @aa:24, or @aa:32]
 - Immediate [#xx:8, #xx:16, or #xx:32]
 - Program-counter relative [@(d:8,PC) or @(d:16,PC)]
 - Memory indirect [@@aa:8]
- 16-Mbyte address space
 - Program: 16 Mbytes
 - Data: 16 Mbytes (4 Gbytes architecturally)

- High-speed operation
 - All frequently-used instructions execute in one or two states
 - Maximum clock rate: 20 MHz
 - 8/16/32-bit register-register add/subtract: 50 ns
 - 8 × 8-bit register-register multiply: 600 ns
 - 16 ÷ 8-bit register-register divide: 600 ns
 - 16 × 16-bit register-register multiply: 1000 ns
 - 32 ÷ 16-bit register-register divide: 1000 ns
- Two CPU operating modes
 - Normal mode
 - Advanced mode
- Power-down state
 - Transition to power-down state by SLEEP instruction
 - CPU clock speed selection

2.1.2 Differences between H8S/2600 CPU and H8S/2000 CPU

The differences between the H8S/2600 CPU and the H8S/2000 CPU are shown below.

- Register configuration

The MAC register is supported only by the H8S/2600 CPU.
- Basic instructions

The four instructions MAC, CLRMAC, LDMAC, and STMAC are supported only by the H8S/2600 CPU.
- Number of execution states

The number of execution states of the MULXU and MULXS instructions differ as follows.

| Instruction | Mnemonic | Number of Execution States | |
|-------------|-----------------|----------------------------|----------|
| | | H8S/2600 | H8S/2000 |
| MULXU | MULXU.B Rs, Rd | 3 | 12 |
| | MULXU.W Rs, ERd | 4 | 20 |
| MULXS | MULXS.B Rs, Rd | 4 | 13 |
| | MULXS.W Rs, ERd | 5 | 21 |

There are also differences in the address space, EXR register functions, power-down state, etc., depending on the product.

2.1.3 Differences from H8/300 CPU

In comparison to the H8/300 CPU, the H8S/2000 CPU has the following enhancements.

- More general registers and control registers
 - Eight 16-bit extended registers, and one 8-bit control register, have been added.
- Expanded address space
 - Normal mode supports the same 64-kbyte address space as the H8/300 CPU.
 - Advanced mode supports a maximum 16-Mbyte address space.
- Enhanced addressing
 - The addressing modes have been enhanced to make effective use of the 16-Mbyte address space.
- Enhanced instructions
 - Addressing modes of bit-manipulation instructions have been enhanced.
 - Signed multiply and divide instructions have been added.
 - Two-bit shift instructions have been added.
 - Instructions for saving and restoring multiple registers have been added.
 - A test and set instruction has been added.
- Higher speed
 - Basic instructions execute twice as fast.

2.1.4 Differences from H8/300H CPU

In comparison to the H8/300H CPU, the H8S/2000 CPU has the following enhancements.

- Additional control register
 - One 8-bit control register has been added.
- Enhanced instructions
 - Addressing modes of bit-manipulation instructions have been enhanced.
 - Two-bit shift instructions have been added.
 - Instructions for saving and restoring multiple registers have been added.
 - A test and set instruction has been added.
- Higher speed
 - Basic instructions execute twice as fast.

2.2 CPU Operating Modes

The H8S/2000 CPU has two operating modes: normal and advanced. Normal mode supports a maximum 64-kbyte address space. Advanced mode supports a maximum 16-Mbyte total address space (architecturally the maximum total address space is 4 Gbytes, with a maximum of 16 Mbytes for the program area and a maximum of 4 Gbytes for the data area). The mode is selected by the mode pins of the microcontroller.

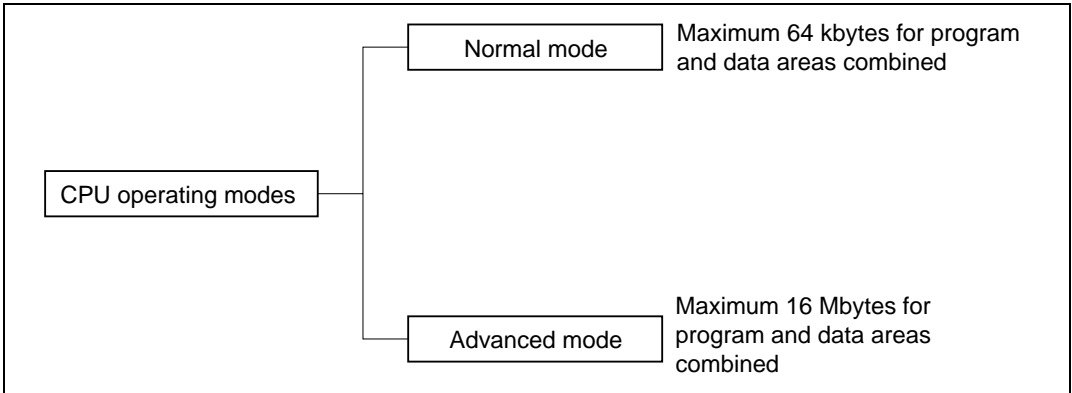


Figure 2.1 CPU Operating Modes

(1) Normal Mode

The exception vector table and stack have the same structure as in the H8/300 CPU.

Address Space: A maximum address space of 64 kbytes can be accessed.

Extended Registers (En): The extended registers (E0 to E7) can be used as 16-bit registers, or as the upper 16-bit segments of 32-bit registers. When En is used as a 16-bit register it can contain any value, even when the corresponding general register (Rn) is used as an address register. If the general register is referenced in the register indirect addressing mode with pre-decrement (@-Rn) or post-increment (@Rn+) and a carry or borrow occurs, however, the value in the corresponding extended register (En) will be affected.

Instruction Set: All instructions and addressing modes can be used. Only the lower 16 bits of effective addresses (EA) are valid.

Exception Vector Table and Memory Indirect Branch Addresses: In normal mode the top area starting at H'0000 is allocated to the exception vector table. One branch address is stored per 16 bits. The configuration of the exception vector table in normal mode is shown in figure 2.2. For details of the exception vector table, see section 4, Exception Handling.

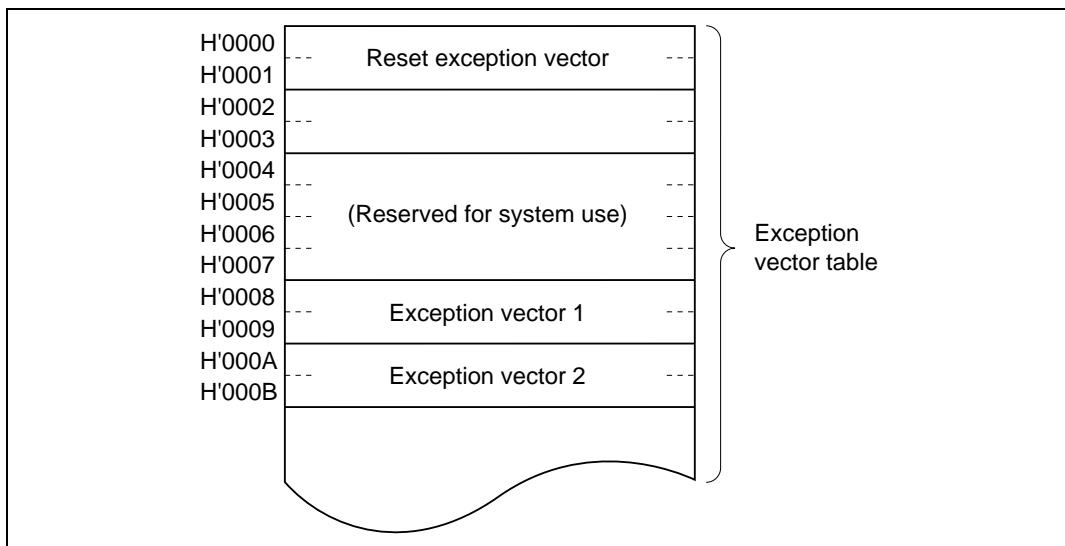


Figure 2.2 Exception Vector Table (Normal Mode)

The memory indirect addressing mode (@@aa:8) employed in the JMP and JSR instructions uses an 8-bit absolute address included in the instruction code to specify a memory operand that contains a branch address. In normal mode the operand is a 16-bit word operand, providing a 16-bit branch address. Branch addresses can be stored in the top area from H'0000 to H'00FF. Note that this area is also used for the exception vector table.

Stack Structure: When the program counter (PC) is pushed onto the stack in a subroutine call, and the PC and condition-code register (CCR) are pushed onto the stack in exception handling, they are stored as shown in figure 2.3. The extended control register (EXR) is not pushed onto the stack. For details, see section 4, Exception Handling.

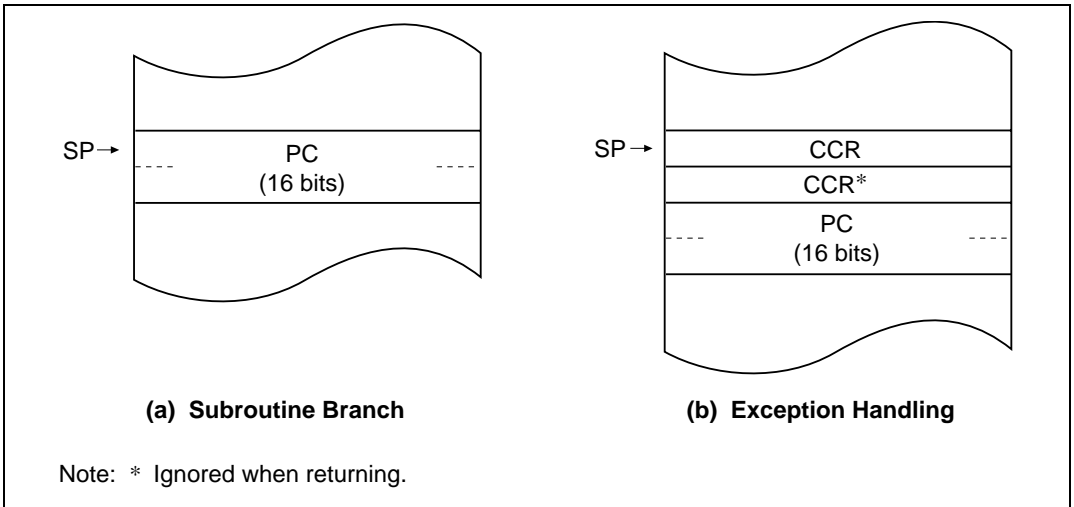


Figure 2.3 Stack Structure in Normal Mode

(2) Advanced Mode

Address Space: Linear access is provided to a 16-Mbyte maximum address space (architecturally a maximum 16-Mbyte program area and a maximum 4-Gbyte data area, with a maximum of 4 Gbytes for program and data areas combined).

Extended Registers (En): The extended registers (E0 to E7) can be used as 16-bit registers, or as the upper 16-bit segments of 32-bit registers or address registers.

Instruction Set: All instructions and addressing modes can be used.

Exception Vector Table and Memory Indirect Branch Addresses: In advanced mode the top area starting at H'00000000 is allocated to the exception vector table in units of 32 bits. In each 32 bits, the upper 8 bits are ignored and a branch address is stored in the lower 24 bits (figure 2.4). For details of the exception vector table, see section 4, Exception Handling.

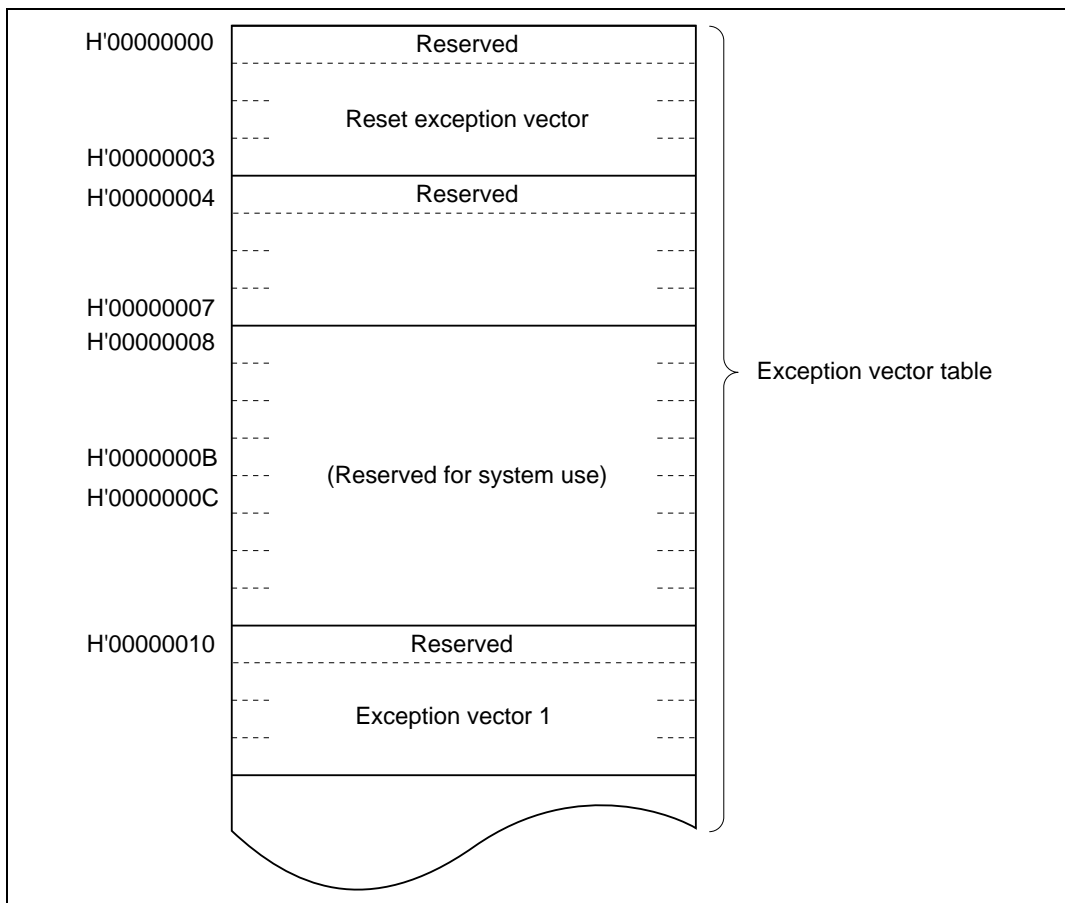


Figure 2.4 Exception Vector Table (Advanced Mode)

The memory indirect addressing mode (@@aa:8) employed in the JMP and JSR instructions uses an 8-bit absolute address included in the instruction code to specify a memory operand that contains a branch address. In advanced mode the operand is a 32-bit longword operand, providing a 32-bit branch address. The upper 8 bits of these 32 bits are a reserved area that is regarded as H'00. Branch addresses can be stored in the area from H'00000000 to H'000000FF. Note that the first part of this range is also the exception vector table.

Stack Structure: In advanced mode, when the program counter (PC) is pushed onto the stack in a subroutine call, and the PC and condition-code register (CCR) are pushed onto the stack in exception handling, they are stored as shown in figure 2.5. The extended control register (EXR) is not pushed onto the stack. For details, see section 4, Exception Handling.

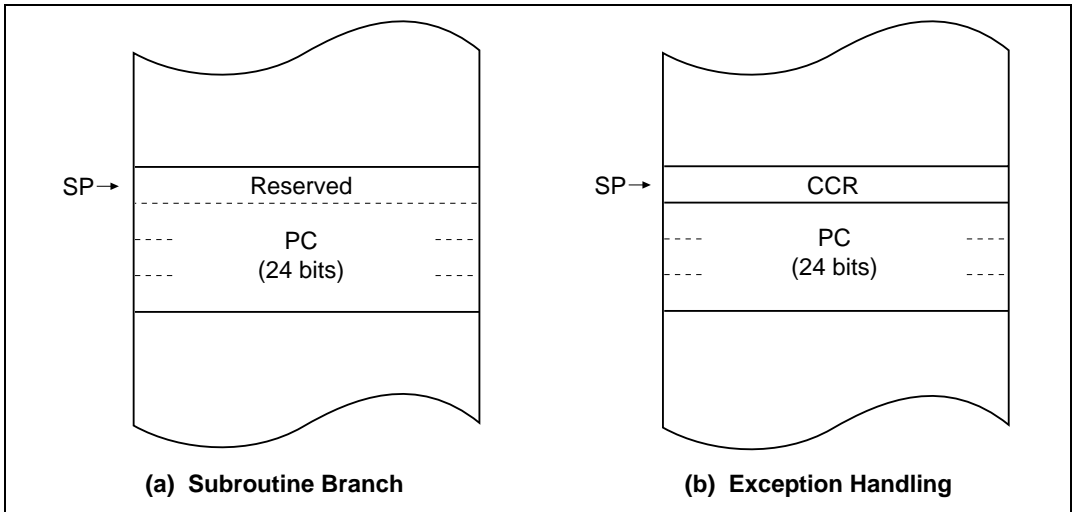


Figure 2.5 Stack Structure in Advanced Mode

2.3 Address Space

Figure 2.6 shows a memory map of the H8S/2000 CPU. The H8S/2000 CPU provides linear access to a maximum 64-kbyte address space in normal mode, and a maximum 16-Mbyte (architecturally 4-Gbyte) address space in advanced mode.

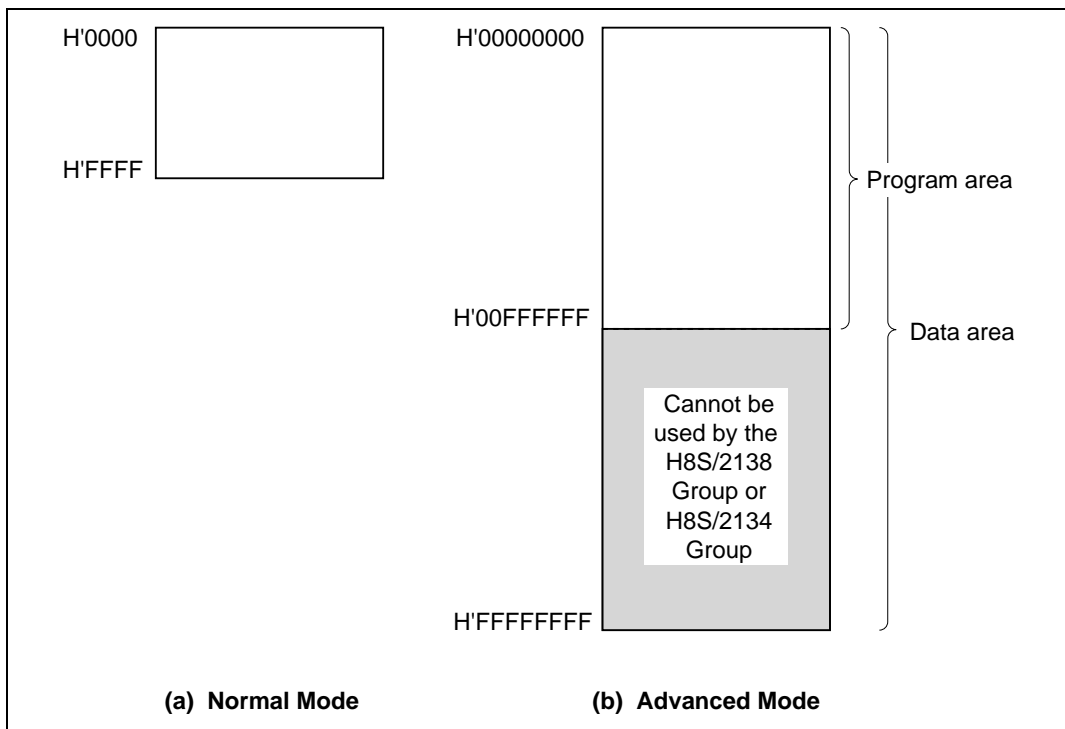


Figure 2.6 Memory Map

2.4 Register Configuration

2.4.1 Overview

The CPU has the internal registers shown in figure 2.7. There are two types of registers: general registers and control registers.

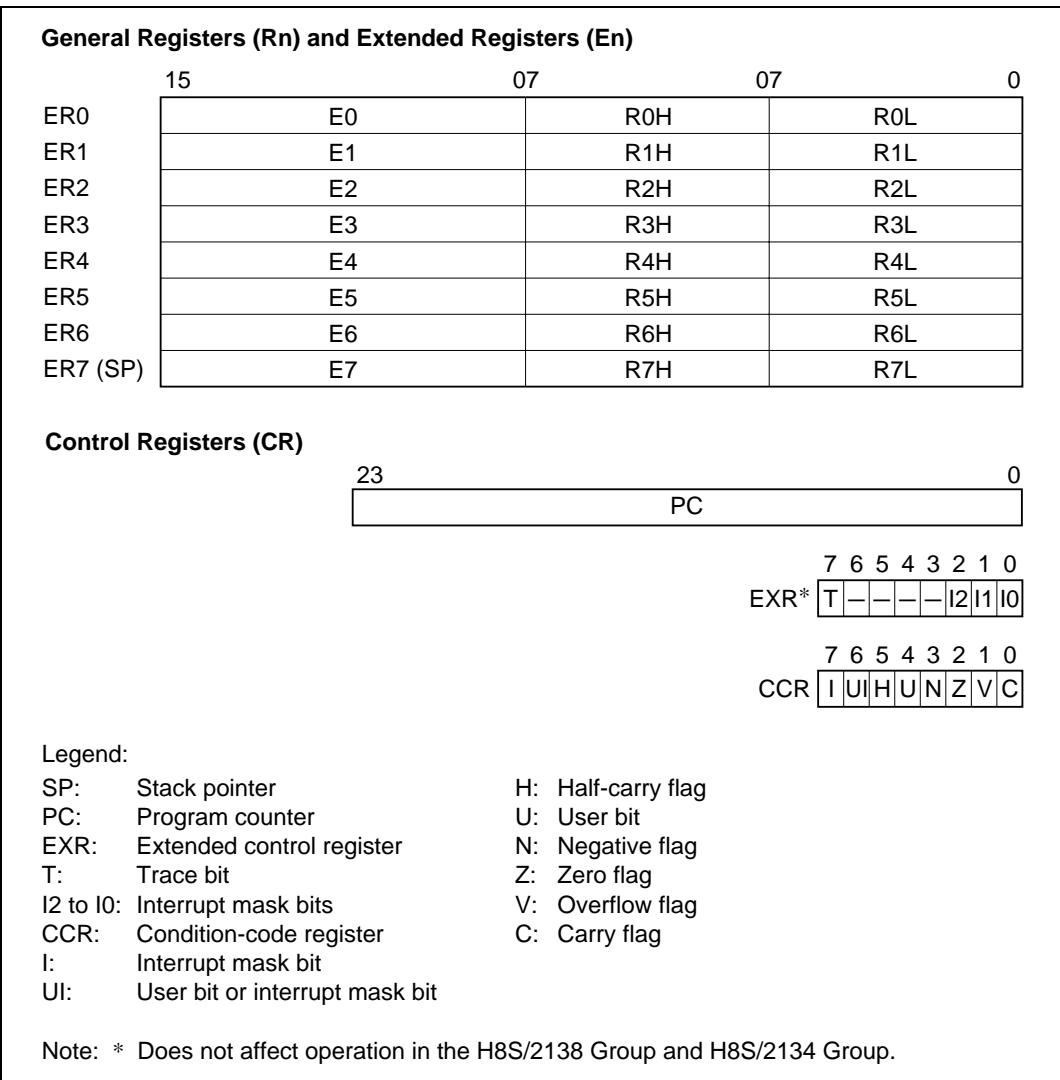


Figure 2.7 CPU Registers

2.4.2 General Registers

The CPU has eight 32-bit general registers. These general registers are all functionally alike and can be used as both address registers and data registers. When a general register is used as a data register, it can be accessed as a 32-bit, 16-bit, or 8-bit register. When the general registers are used as 32-bit registers or address registers, they are designated by the letters ER (ER0 to ER7).

The ER registers divide into 16-bit general registers designated by the letters E (E0 to E7) and R (R0 to R7). These registers are functionally equivalent, providing a maximum of sixteen 16-bit registers. The E registers (E0 to E7) are also referred to as extended registers.

The R registers divide into 8-bit general registers designated by the letters RH (R0H to R7H) and RL (R0L to R7L). These registers are functionally equivalent, providing a maximum of sixteen 8-bit registers.

Figure 2.8 illustrates the usage of the general registers. The usage of each register can be selected independently.

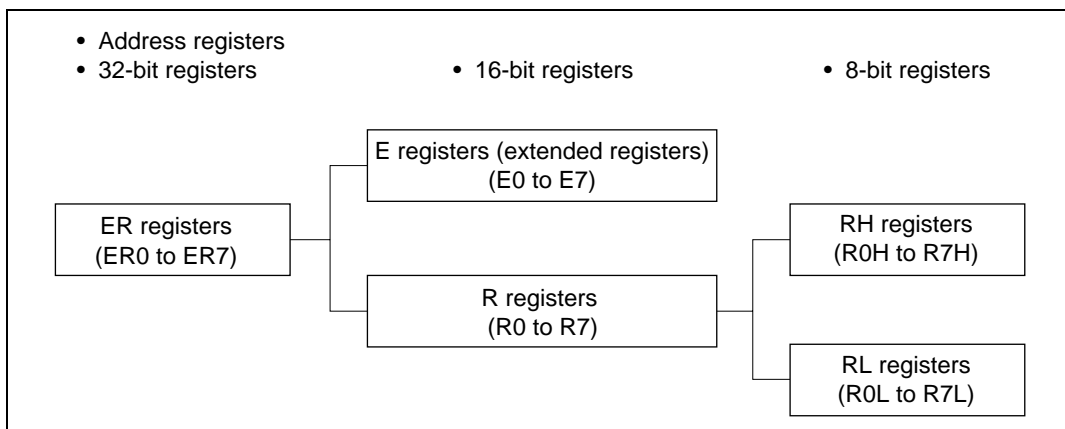


Figure 2.8 Usage of General Registers

General register ER7 has the function of stack pointer (SP) in addition to its general-register function, and is used implicitly in exception handling and subroutine calls. Figure 2.9 shows the stack.

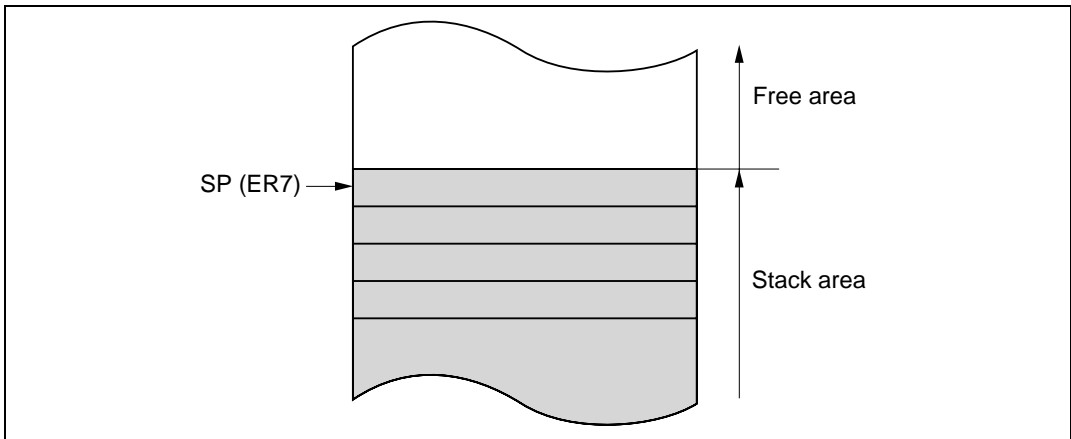


Figure 2.9 Stack

2.4.3 Control Registers

The control registers are the 24-bit program counter (PC), 8-bit extended control register (EXR), and 8-bit condition-code register (CCR).

(1) Program Counter (PC)

This 24-bit counter indicates the address of the next instruction the CPU will execute. The length of all CPU instructions is 2 bytes (one word), so the least significant PC bit is ignored. (When an instruction is fetched, the least significant PC bit is regarded as 0.)

(2) Extended Control Register (EXR)

An 8-bit register. In the H8S/2138 Group and H8S/2134 Group, this register does not affect operation.

Bit 7—Trace Bit (T): This bit is reserved. In the H8S/2138 Group and H8S/2134 Group, this bit does not affect operation.

Bits 6 to 3—Reserved: These bits are reserved. They are always read as 1.

Bits 2 to 0—Interrupt Mask Bits (I2 to I0): These bits are reserved. In the H8S/2138 Group and H8S/2134 Group, these bits do not affect operation.

(3) Condition-Code Register (CCR)

This 8-bit register contains internal CPU status information, including an interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags.

Bit 7—Interrupt Mask Bit (I): Masks interrupts other than NMI when set to 1. (NMI is accepted regardless of the I bit setting.) The I bit is set to 1 by hardware at the start of an exception-handling sequence. For details, refer to section 5, Interrupt Controller.

Bit 6—User Bit or Interrupt Mask Bit (UI): Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions. This bit can also be used as an interrupt mask bit. For details, refer to section 5, Interrupt Controller.

Bit 5—Half-Carry Flag (H): When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B, or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and cleared to 0 otherwise. When the ADD.W, SUB.W, CMP.W, or NEG.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and cleared to 0 otherwise. When the ADD.L, SUB.L, CMP.L, or NEG.L instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 27, and cleared to 0 otherwise.

Bit 4—User Bit (U): Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.

Bit 3—Negative Flag (N): Stores the value of the most significant bit (sign bit) of data.

Bit 2—Zero Flag (Z): Set to 1 to indicate zero data, and cleared to 0 to indicate non-zero data.

Bit 1—Overflow Flag (V): Set to 1 when an arithmetic overflow occurs, and cleared to 0 otherwise.

Bit 0—Carry Flag (C): Set to 1 when a carry occurs, and cleared to 0 otherwise. Used by:

- Add instructions, to indicate a carry
- Subtract instructions, to indicate a borrow
- Shift and rotate instructions, to store the carry

The carry flag is also used as a bit accumulator by bit-manipulation instructions.

Some instructions leave some or all of the flag bits unchanged. For the action of each instruction on the flag bits, refer to appendix A.1, Instruction.

Operations can be performed on the CCR bits by the LDC, STC, ANDC, ORC, and XORC instructions. The N, Z, V, and C flags are used as branching conditions for conditional branch (Bcc) instructions.

2.4.4 Initial Register Values

Reset exception handling loads the CPU's program counter (PC) from the vector table, clears the trace bit in EXR to 0, and sets the interrupt mask bits in CCR and EXR to 1. The other CCR bits and the general registers are not initialized. In particular, the stack pointer (ER7) is not initialized. The stack pointer should therefore be initialized by an MOV.L instruction executed immediately after a reset.

2.5 Data Formats

The CPU can process 1-bit, 4-bit (BCD), 8-bit (byte), 16-bit (word), and 32-bit (longword) data. Bit-manipulation instructions operate on 1-bit data by accessing bit n ($n = 0, 1, 2, \dots, 7$) of byte operand data. The DAA and DAS decimal-adjust instructions treat byte data as two digits of 4-bit BCD data.

2.5.1 General Register Data Formats

Figure 2.10 shows the data formats in general registers.

| Data Type | General Register | Data Format |
|----------------|------------------|---|
| 1-bit data | RnH | <p>7 0 7 6 5 4 3 2 1 0 Don't care</p> |
| 1-bit data | RnL | <p>7 0 Don't care 7 6 5 4 3 2 1 0</p> |
| 4-bit BCD data | RnH | <p>7 4 3 0 Upper digit Lower digit Don't care</p> |
| 4-bit BCD data | RnL | <p>7 4 3 0 Don't care Upper digit Lower digit</p> |
| Byte data | RnH | <p>7 0 MSB LSB Don't care</p> |
| Byte data | RnL | <p>7 0 Don't care MSB LSB</p> |

Figure 2.10 General Register Data Formats

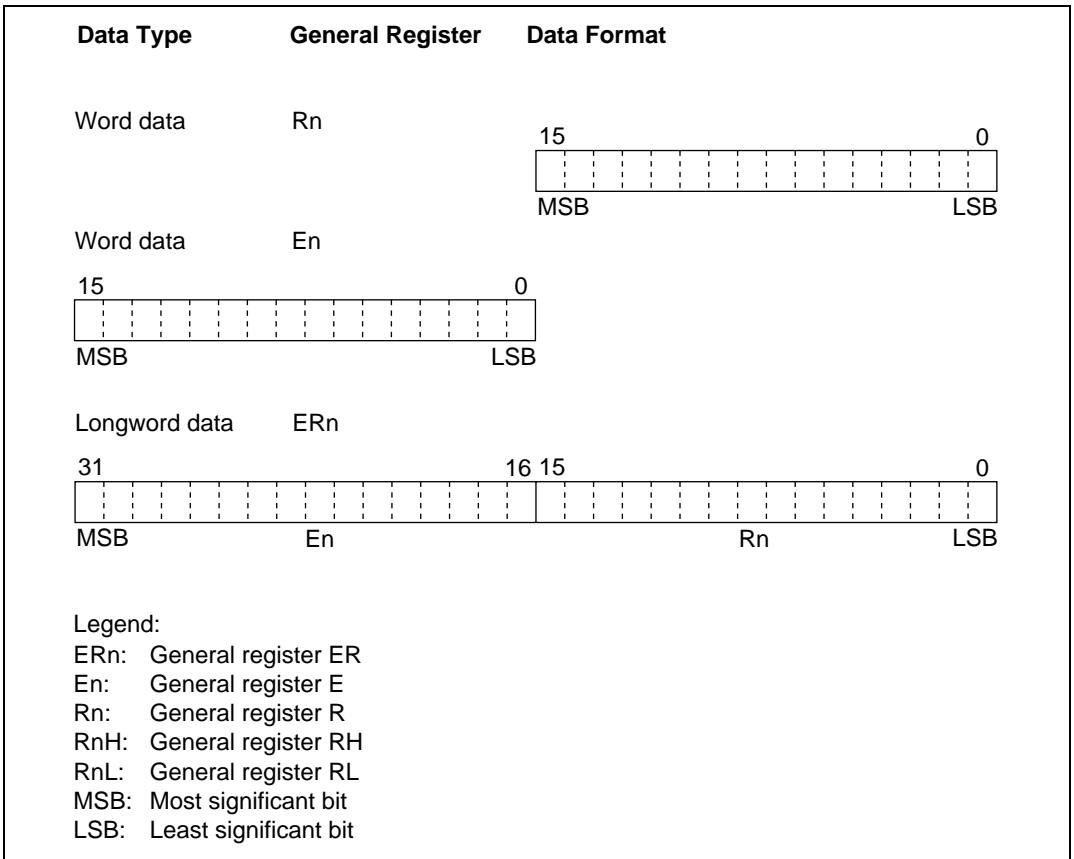


Figure 2.10 General Register Data Formats (cont)

2.5.2 Memory Data Formats

Figure 2.11 shows the data formats in memory. The CPU can access word data and longword data in memory, but word or longword data must begin at an even address. If an attempt is made to access word or longword data at an odd address, no address error occurs but the least significant bit of the address is regarded as 0, so the access starts at the preceding address. This also applies to instruction fetches.

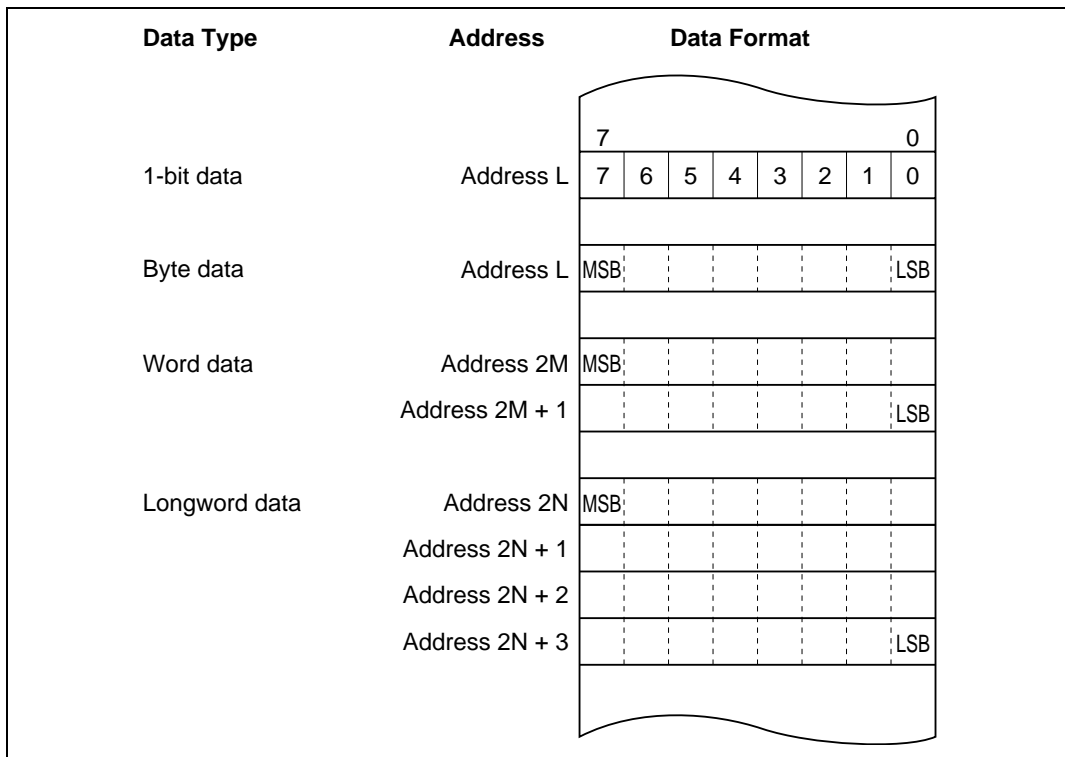


Figure 2.11 Memory Data Formats

When ER7 (SP) is used as an address register to access the stack, the operand size should be word size or longword size.

2.6 Instruction Set

2.6.1 Overview

The H8S/2000 CPU has 65 types of instructions. The instructions are classified by function in table 2.1.

Table 2.1 Instruction Classification

| Function | Instructions | Size | Types |
|-----------------------|---|------|-------|
| Data transfer | MOV | BWL | 5 |
| | POP ^{*1} , PUSH ^{*1} | WL | |
| | LDM ^{*5} , STM ^{*5} | L | |
| | MOVFPE ^{*3} , MOVTPPE ^{*3} | B | |
| Arithmetic operations | ADD, SUB, CMP, NEG | BWL | 19 |
| | ADDX, SUBX, DAA, DAS | B | |
| | INC, DEC | BWL | |
| | ADDS, SUBS | L | |
| | MULXU, DIVXU, MULXS, DIVXS | BW | |
| | EXTU, EXTS | WL | |
| | TAS ^{*4} | B | |
| Logic operations | AND, OR, XOR, NOT | BWL | 4 |
| Shift | SHAL, SHAR, SHLL, SHLR, ROTL, ROTR, ROTXL, ROTXR | BWL | 8 |
| Bit manipulation | BSET, BCLR, BNOT, BTST, BLD, BILD, BST, BIST, BAND, BIAND, BOR, BIOR, BXOR, BIXOR | B | 14 |
| Branch | Bcc ^{*2} , JMP, BSR, JSR, RTS | — | 5 |
| System control | TRAPA, RTE, SLEEP, LDC, STC, ANDC, ORC, XORC, NOP | — | 9 |
| Block data transfer | EPMOV | — | 1 |

Total: 65 types

Legend: B: Byte
W: Word
L: Longword

- Notes: 1. POP.W Rn and PUSH.W Rn are identical to MOV.W @SP+, Rn and MOV.W Rn, @-SP. POP.L ERn and PUSH.L ERn are identical to MOV.L @SP+, ERn and MOV.L ERn, @-SP.
2. Bcc is the general name for conditional branch instructions.
3. Cannot be used in the H8S/2138 Group or H8S/2134 Group.
4. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
5. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

2.6.2 Instructions and Addressing Modes

Table 2.2 indicates the combinations of instructions and addressing modes that the H8S/2000 CPU can use.

Table 2.2 Combinations of Instructions and Addressing Modes

| Function | Instruction | Addressing Modes | | | | | | | | | | | | | |
|-----------------------|--|------------------|-----|------|-------------|-------------|-------------|-------|--------|--------|--------|-----------|------------|--------|----|
| | | #xx | Rn | @ERn | @(d:16,ERn) | @(d:32,ERn) | @-ERn/@ERn+ | @aa:8 | @aa:16 | @aa:24 | @aa:32 | @(d:8,PC) | @(d:16,PC) | @@aa:8 | |
| Data transfer | MOV | BWL | BWL | BWL | BWL | BWL | BWL | B | BWL | — | BWL | — | — | — | — |
| | POP, PUSH | — | — | — | — | — | — | — | — | — | — | — | — | — | WL |
| | LDM ^{*3} , STM ^{*3} | — | — | — | — | — | — | — | — | — | — | — | — | — | L |
| | MOVFP ^{*1} , MOVTP ^{*1} | — | — | — | — | — | — | — | B | — | — | — | — | — | — |
| Arithmetic operations | ADD, CMP | BWL | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| | SUB | WL | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| | ADDX, SUBX | B | B | — | — | — | — | — | — | — | — | — | — | — | — |
| | ADDS, SUBS | — | L | — | — | — | — | — | — | — | — | — | — | — | — |
| | INC, DEC | — | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| | DAA, DAS | — | B | — | — | — | — | — | — | — | — | — | — | — | — |
| | MULXU, DIVXU | — | BW | — | — | — | — | — | — | — | — | — | — | — | — |
| | MULXS, DIVXS | — | BW | — | — | — | — | — | — | — | — | — | — | — | — |
| | NEG | — | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| | EXTU, EXTS | — | WL | — | — | — | — | — | — | — | — | — | — | — | — |
| TAS ^{*2} | — | — | B | — | — | — | — | — | — | — | — | — | — | — | |
| Logic operations | AND, OR, XOR | BWL | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| | NOT | — | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| Shift | | — | BWL | — | — | — | — | — | — | — | — | — | — | — | — |
| Bit manipulation | | — | B | B | — | — | — | B | B | — | B | — | — | — | — |
| Branch | Bcc, BSR | — | — | — | — | — | — | — | — | — | — | ○ | ○ | — | — |
| | JMP, JSR | — | — | — | — | — | — | — | — | ○ | — | — | — | ○ | — |
| | RTS | — | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| System control | TRAPA | — | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| | RTE | — | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| | SLEEP | — | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| | LDC | B | B | W | W | W | W | — | W | — | W | — | — | — | — |
| | STC | — | B | W | W | W | W | — | W | — | W | — | — | — | — |
| | ANDC, ORC, XORC | B | — | — | — | — | — | — | — | — | — | — | — | — | — |
| | NOP | — | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| Block data transfer | | — | — | — | — | — | — | — | — | — | — | — | — | — | BW |

Legend: B: Byte
W: Word
L: Longword

Notes: 1. Cannot be used in the H8S/2138 Group or H8S/2134 Group.
2. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
3. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

2.6.3 Table of Instructions Classified by Function

Table 2.3 summarizes the instructions in each functional category. The notation used in table 2.3 is defined below.

Operation Notation

| | |
|----------------|------------------------------------|
| Rd | General register (destination)* |
| Rs | General register (source)* |
| Rn | General register* |
| ERn | General register (32-bit register) |
| (EAd) | Destination operand |
| (EAs) | Source operand |
| EXR | Extended control register |
| CCR | Condition-code register |
| N | N (negative) flag in CCR |
| Z | Z (zero) flag in CCR |
| V | V (overflow) flag in CCR |
| C | C (carry) flag in CCR |
| PC | Program counter |
| SP | Stack pointer |
| #IMM | Immediate data |
| disp | Displacement |
| + | Addition |
| − | Subtraction |
| × | Multiplication |
| ÷ | Division |
| ^ | Logical AND |
| ∨ | Logical OR |
| ⊕ | Logical exclusive OR |
| → | Move |
| ¬ | NOT (logical complement) |
| :8/:16/:24/:32 | 8-, 16-, 24-, or 32-bit length |

Note: * General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit registers (ER0 to ER7).

Table 2.3 Instructions Classified by Function

| Type | Instruction | Size ^{*1} | Function |
|---------------|-------------------|--------------------|---|
| Data transfer | MOV | B/W/L | (EAs) → Rd, Rs → (EAd) Moves data between two general registers or between a general register and memory, or moves immediate data to a general register. |
| | MOVFP | B | Cannot be used in the H8S/2138 Group or H8S/2134 Group. |
| | MOVTP | B | Cannot be used in the H8S/2138 Group or H8S/2134 Group. |
| | POP | W/L | @SP+ → Rn Pops a general register from the stack. POP.W Rn is identical to MOV.W @SP+, Rn. POP.L ERn is identical to MOV.L @SP+, ERn. |
| | PUSH | W/L | Rn → @-SP Pushes a general register onto the stack. PUSH.W Rn is identical to MOV.W Rn, @-SP. PUSH.L ERn is identical to MOV.L ERn, @-SP. |
| | LDM ^{*3} | L | @SP+ → Rn (register list) Pops two or more general registers from the stack. |
| | STM ^{*3} | L | Rn (register list) → @-SP Pushes two or more general registers onto the stack. |

| Type | Instruction | Size*1 | Function |
|-----------------------|--------------|--------|---|
| Arithmetic operations | ADD SUB | B/W/L | $Rd \pm Rs \rightarrow Rd$, $Rd \pm \#IMM \rightarrow Rd$ Performs addition or subtraction on data in two general registers, or on immediate data and data in a general register. (Immediate byte data cannot be subtracted from byte data in a general register. Use the SUBX or ADD instruction.) |
| | ADDX SUBX | B | $Rd \pm Rs \pm C \rightarrow Rd$, $Rd \pm \#IMM \pm C \rightarrow Rd$ Performs addition or subtraction with carry on byte data in two general registers, or on immediate data and data in a general register. |
| | INC DEC | B/W/L | $Rd \pm 1 \rightarrow Rd$, $Rd \pm 2 \rightarrow Rd$ Increments or decrements a general register by 1 or 2. (Byte operands can be incremented or decremented by 1 only.) |
| | ADDS SUBS | L | $Rd \pm 1 \rightarrow Rd$, $Rd \pm 2 \rightarrow Rd$, $Rd \pm 4 \rightarrow Rd$ Adds or subtracts the value 1, 2, or 4 to or from data in a 32-bit register. |
| | DAA DAS | B | Rd decimal adjust $\rightarrow Rd$ Decimal-adjusts an addition or subtraction result in a general register by referring to the CCR to produce 4-bit BCD data. |
| | MULXU | B/W | $Rd \times Rs \rightarrow Rd$ Performs unsigned multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits. |
| | MULXS | B/W | $Rd \times Rs \rightarrow Rd$ Performs signed multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits. |
| | DIVXU | B/W | $Rd \div Rs \rightarrow Rd$ Performs unsigned division on data in two general registers: either 16 bits \div 8 bits \rightarrow 8-bit quotient and 8-bit remainder or 32 bits \div 16 bits \rightarrow 16-bit quotient and 16-bit remainder. |

| Type | Instruction | Size*1 | Function |
|-----------------------|-------------|--------|---|
| Arithmetic operations | DIVXS | B/W | $Rd \div Rs \rightarrow Rd$ Performs signed division on data in two general registers: either 16 bits \div 8 bits \rightarrow 8-bit quotient and 8-bit remainder or 32 bits \div 16 bits \rightarrow 16-bit quotient and 16-bit remainder. |
| | CMP | B/W/L | $Rd - Rs$, $Rd - \#IMM$ Compares data in a general register with data in another general register or with immediate data, and sets CCR bits according to the result. |
| | NEG | B/W/L | $0 - Rd \rightarrow Rd$ Takes the two's complement (arithmetic complement) of data in a general register. |
| | EXTU | W/L | Rd (zero extension) $\rightarrow Rd$ Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by padding with zeros on the left. |
| | EXTS | W/L | Rd (sign extension) $\rightarrow Rd$ Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by extending the sign bit. |
| | TAS | B | $@ERd - 0, 1 \rightarrow (<bit 7> \text{ of } @ERd)^{*2}$ Tests memory contents, and sets the most significant bit (bit 7) to 1. |

| Type | Instruction | Size*1 | Function |
|------------------|----------------|--------|---|
| Logic operations | AND | B/W/L | $Rd \wedge Rs \rightarrow Rd$, $Rd \wedge \#IMM \rightarrow Rd$ Performs a logical AND operation on a general register and another general register or immediate data. |
| | OR | B/W/L | $Rd \vee Rs \rightarrow Rd$, $Rd \vee \#IMM \rightarrow Rd$ Performs a logical OR operation on a general register and another general register or immediate data. |
| | XOR | B/W/L | $Rd \oplus Rs \rightarrow Rd$, $Rd \oplus \#IMM \rightarrow Rd$ Performs a logical exclusive OR operation on a general register and another general register or immediate data. |
| | NOT | B/W/L | $\neg (Rd) \rightarrow (Rd)$ Takes the one's complement (logical complement) of general register contents. |
| Shift operations | SHAL SHAR | B/W/L | $Rd \text{ (shift)} \rightarrow Rd$ Performs an arithmetic shift on general register contents. A 1-bit or 2-bit shift is possible. |
| | SHLL SHLR | B/W/L | $Rd \text{ (shift)} \rightarrow Rd$ Performs a logical shift on general register contents. A 1-bit or 2-bit shift is possible. |
| | ROTL ROTR | B/W/L | $Rd \text{ (rotate)} \rightarrow Rd$ Rotates general register contents. 1-bit or 2-bit rotation is possible. |
| | ROTXL ROTXR | B/W/L | $Rd \text{ (rotate)} \rightarrow Rd$ Rotates general register contents through the carry flag. 1-bit or 2-bit rotation is possible. |

| Type | Instruction | Size*1 | Function |
|-------------------------------|-------------|--------|---|
| Bit-manipulation instructions | BSET | B | $1 \rightarrow (\text{<bit-No.> of <EAd>})$ Sets a specified bit in a general register or memory operand to 1. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| | BCLR | B | $0 \rightarrow (\text{<bit-No.> of <EAd>})$ Clears a specified bit in a general register or memory operand to 0. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| | BNOT | B | $\neg (\text{<bit-No.> of <EAd>}) \rightarrow (\text{<bit-No.> of <EAd>})$ Inverts a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| | BTST | B | $\neg (\text{<bit-No.> of <EAd>}) \rightarrow Z$ Tests a specified bit in a general register or memory operand and sets or clears the Z flag accordingly. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| | BAND | B | $C \wedge (\text{<bit-No.> of <EAd>}) \rightarrow C$ ANDs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. |
| | BIAND | B | $C \wedge [\neg (\text{<bit-No.> of <EAd>})] \rightarrow C$ ANDs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data. |
| | BOR | B | $C \vee (\text{<bit-No.> of <EAd>}) \rightarrow C$ ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. |
| | BIOR | B | $C \vee [\neg (\text{<bit-No.> of <EAd>})] \rightarrow C$ ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data. |

| Type | Instruction | Size*1 | Function |
|-------------------------------|-------------|--------|--|
| Bit-manipulation instructions | BXOR | B | $C \oplus (\text{<bit-No.> of <EAd>}) \rightarrow C$ Exclusive-ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. |
| | BIXOR | B | $C \oplus [\neg (\text{<bit-No.> of <EAd>})] \rightarrow C$ Exclusive-ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data. |
| | BLD | B | $(\text{<bit-No.> of <EAd>}) \rightarrow C$ Transfers a specified bit in a general register or memory operand to the carry flag. |
| | BILD | B | $\neg (\text{<bit-No.> of <EAd>}) \rightarrow C$ Transfers the inverse of a specified bit in a general register or memory operand to the carry flag. The bit number is specified by 3-bit immediate data. |
| | BST | B | $C \rightarrow (\text{<bit-No.> of <EAd>})$ Transfers the carry flag value to a specified bit in a general register or memory operand. |
| | BIST | B | $\neg C \rightarrow (\text{<bit-No.> of <EAd>})$ Transfers the inverse of the carry flag value to a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data. |

| Type | Instruction | Size*1 | Function | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|---------------------|-------------|--|--|----------------------------|--|-----------|---------|---------------|--------|---------|---------------|-------|-----|------|----------------|-----|-------------|----------------|----------|----------------------------|---------|----------|-----------------|---------|-----|-----------|---------|-----|-------|---------|-----|----------------|---------|-----|--------------|---------|-----|------|---------|-----|-------|---------|-----|------------------|------------------|-----|-----------|------------------|-----|--------------|---------------------------|-----|---------------|---------------------------|
| Branch instructions | Bcc | — | Branches to a specified address if a specified condition is true. The branching conditions are listed below. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | <table border="1"> <thead> <tr> <th>Mnemonic</th> <th>Description</th> <th>Condition</th> </tr> </thead> <tbody> <tr> <td>BRA(BT)</td> <td>Always (true)</td> <td>Always</td> </tr> <tr> <td>BRN(BF)</td> <td>Never (false)</td> <td>Never</td> </tr> <tr> <td>BHI</td> <td>High</td> <td>$C \vee Z = 0$</td> </tr> <tr> <td>BLS</td> <td>Low or same</td> <td>$C \vee Z = 1$</td> </tr> <tr> <td>BCC(BHS)</td> <td>Carry clear (high or same)</td> <td>$C = 0$</td> </tr> <tr> <td>BCS(BLO)</td> <td>Carry set (low)</td> <td>$C = 1$</td> </tr> <tr> <td>BNE</td> <td>Not equal</td> <td>$Z = 0$</td> </tr> <tr> <td>BEQ</td> <td>Equal</td> <td>$Z = 1$</td> </tr> <tr> <td>BVC</td> <td>Overflow clear</td> <td>$V = 0$</td> </tr> <tr> <td>BVS</td> <td>Overflow set</td> <td>$V = 1$</td> </tr> <tr> <td>BPL</td> <td>Plus</td> <td>$N = 0$</td> </tr> <tr> <td>BMI</td> <td>Minus</td> <td>$N = 1$</td> </tr> <tr> <td>BGE</td> <td>Greater or equal</td> <td>$N \oplus V = 0$</td> </tr> <tr> <td>BLT</td> <td>Less than</td> <td>$N \oplus V = 1$</td> </tr> <tr> <td>BGT</td> <td>Greater than</td> <td>$Z \vee (N \oplus V) = 0$</td> </tr> <tr> <td>BLE</td> <td>Less or equal</td> <td>$Z \vee (N \oplus V) = 1$</td> </tr> </tbody> </table> | Mnemonic | Description | Condition | BRA(BT) | Always (true) | Always | BRN(BF) | Never (false) | Never | BHI | High | $C \vee Z = 0$ | BLS | Low or same | $C \vee Z = 1$ | BCC(BHS) | Carry clear (high or same) | $C = 0$ | BCS(BLO) | Carry set (low) | $C = 1$ | BNE | Not equal | $Z = 0$ | BEQ | Equal | $Z = 1$ | BVC | Overflow clear | $V = 0$ | BVS | Overflow set | $V = 1$ | BPL | Plus | $N = 0$ | BMI | Minus | $N = 1$ | BGE | Greater or equal | $N \oplus V = 0$ | BLT | Less than | $N \oplus V = 1$ | BGT | Greater than | $Z \vee (N \oplus V) = 0$ | BLE | Less or equal | $Z \vee (N \oplus V) = 1$ |
| | | | Mnemonic | Description | Condition | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BRA(BT) | Always (true) | Always | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BRN(BF) | Never (false) | Never | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BHI | High | $C \vee Z = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BLS | Low or same | $C \vee Z = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BCC(BHS) | Carry clear (high or same) | $C = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BCS(BLO) | Carry set (low) | $C = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BNE | Not equal | $Z = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BEQ | Equal | $Z = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BVC | Overflow clear | $V = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BVS | Overflow set | $V = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BPL | Plus | $N = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BMI | Minus | $N = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BGE | Greater or equal | $N \oplus V = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BLT | Less than | $N \oplus V = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BGT | Greater than | $Z \vee (N \oplus V) = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | BLE | Less or equal | $Z \vee (N \oplus V) = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | JMP | — | Branches unconditionally to a specified address. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BSR | — | Branches to a subroutine at a specified address. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| JSR | — | Branches to a subroutine at a specified address. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RTS | — | Returns from a subroutine | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

| Type | Instruction | Size*1 | Function |
|-----------------------------|-------------|---|--|
| System control instructions | TRAPA | — | Starts trap-instruction exception handling. |
| | RTE | — | Returns from an exception-handling routine. |
| | SLEEP | — | Causes a transition to a power-down state. |
| | LDC | B/W | (EAs) → CCR, (EAs) → EXR Moves contents of a general register or memory or immediate data to CCR or EXR. Although CCR and EXR are 8-bit registers, word-size transfers are performed between them and memory. The upper 8 bits are valid. |
| | STC | B/W | CCR → (EAd), EXR → (EAd) Transfers CCR or EXR contents to a general register or memory. Although CCR and EXR are 8-bit registers, word-size transfers are performed between them and memory. The upper 8 bits are valid. |
| | ANDC | B | CCR ∧ #IMM → CCR, EXR ∧ #IMM → EXR Logically ANDs the CCR or EXR contents with immediate data. |
| | ORC | B | CCR ∨ #IMM → CCR, EXR ∨ #IMM → EXR Logically ORs the CCR or EXR contents with immediate data. |
| | XORC | B | CCR ⊕ #IMM → CCR, EXR ⊕ #IMM → EXR Logically exclusive-ORs the CCR or EXR contents with immediate data. |
| NOP | — | PC + 2 → PC Only increments the program counter. | |

| Type | Instruction | Size* ¹ | Function |
|----------------------------------|-------------|--------------------|---|
| Block data transfer instructions | EPMOV.B | — | if R4L ≠ 0 then Repeat @ER5+ → @ER6+ R4L-1 → R4L Until R4L = 0 else next; |
| | EPMOV.W | — | if R4 ≠ 0 then Repeat @ER5+ → @ER6+ R4-1 → R4 Until R4 = 0 else next; Block transfer instruction. Transfers the number of data bytes specified by R4L or R4 from locations starting at the address indicated by ER5 to locations starting at the address indicated by ER6. After the transfer, the next instruction is executed. |

Notes: 1. Size refers to the operand size.

B: Byte

W: Word

L: Longword

2. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
3. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

2.6.4 Basic Instruction Formats

The CPU instructions consist of 2-byte (1-word) units. An instruction consists of an operation field (op field), a register field (r field), an effective address extension (EA field), and a condition field (cc).

Operation Field: Indicates the function of the instruction, the addressing mode, and the operation to be carried out on the operand. The operation field always includes the first four bits of the instruction. Some instructions have two operation fields.

Register Field: Specifies a general register. Address registers are specified by 3 bits, data registers by 3 bits or 4 bits. Some instructions have two register fields. Some have no register field.

Effective Address Extension: Eight, 16, or 32 bits specifying immediate data, an absolute address, or a displacement.

Condition Field: Specifies the branching condition of Bcc instructions.

Figure 2.12 shows examples of instruction formats.

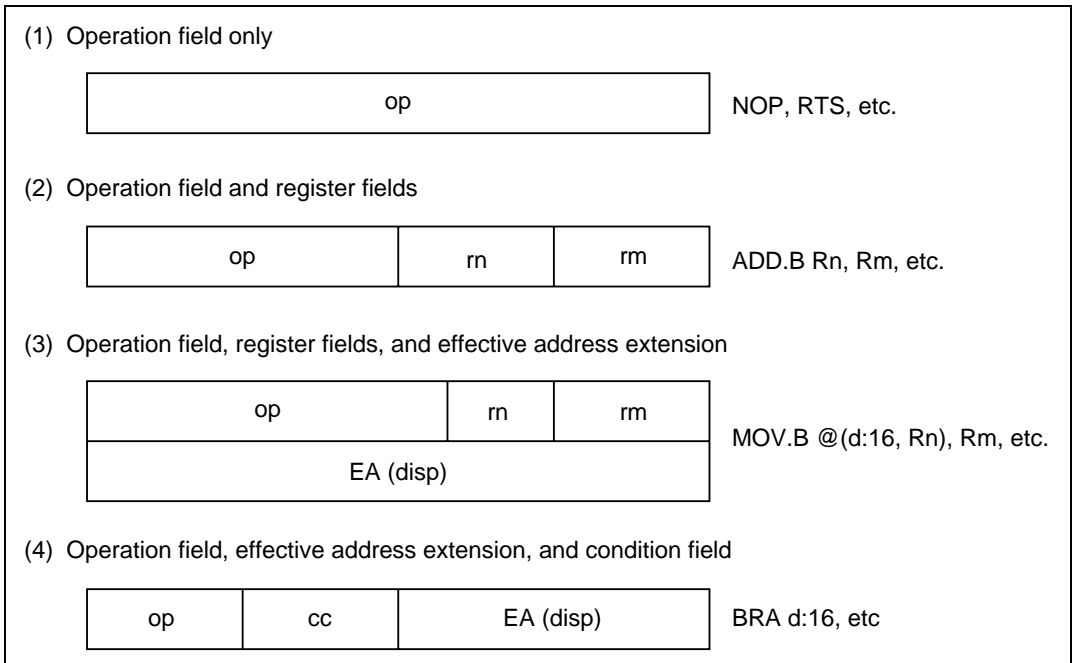


Figure 2.12 Instruction Formats (Examples)

2.6.5 Notes on Use of Bit-Manipulation Instructions

The BSET, BCLR, BNOT, BST, and BIST instructions read a byte of data, carry out bit manipulation, then write back the byte of data. Caution is therefore required when using these instructions on a register containing write-only bits, or a port.

The BCLR instruction can be used to clear internal I/O register flags to 0. In this case, the relevant flag need not be read beforehand if it is clear that it has been set to 1 in an interrupt handling routine, etc.

2.7 Addressing Modes and Effective Address Calculation

2.7.1 Addressing Mode

The CPU supports the eight addressing modes listed in table 2.4. Each instruction uses a subset of these addressing modes. Arithmetic and logic instructions can use the register direct and immediate modes. Data transfer instructions can use all addressing modes except program-counter relative and memory indirect. Bit-manipulation instructions use register direct, register indirect, or absolute addressing mode to specify an operand, and register direct (BSET, BCLR, BNOT, and BTST instructions) or immediate (3-bit) addressing mode to specify a bit number in the operand.

Table 2.4 Addressing Modes

| No. | Addressing Mode | Symbol |
|-----|---|----------------------------|
| 1 | Register direct | Rn |
| 2 | Register indirect | @ERn |
| 3 | Register indirect with displacement | @(d:16,ERn)/@(d:32,ERn) |
| 4 | Register indirect with post-increment Register indirect with pre-decrement | @ERn+ @-ERn |
| 5 | Absolute address | @aa:8/@aa:16/@aa:24/@aa:32 |
| 6 | Immediate | #xx:8/#xx:16/#xx:32 |
| 7 | Program-counter relative | @(d:8,PC)/@(d:16,PC) |
| 8 | Memory indirect | @@aa:8 |

Register Direct—Rn: The register field of the instruction code specifies an 8-, 16-, or 32-bit general register containing the operand. R0H to R7H and R0L to R7L can be specified as 8-bit registers. R0 to R7 and E0 to E7 can be specified as 16-bit registers. ER0 to ER7 can be specified as 32-bit registers.

Register Indirect—@ERn: The register field of the instruction code specifies an address register (ERn) which contains the address of the operand in memory. If the address is a program instruction address, the lower 24 bits are valid and the upper 8 bits are all assumed to be 0 (H'00).

Register Indirect with Displacement—@(d:16, ERn) or @(d:32, ERn): A 16-bit or 32-bit displacement contained in the instruction is added to an address register (ERn) specified by the register field of the instruction, and the sum gives the address of a memory operand. A 16-bit displacement is sign-extended when added.

Register Indirect with Post-Increment or Pre-Decrement—@ERn+ or @-ERn:

- Register indirect with post-increment—@ERn+
The register field of the instruction code specifies an address register (ERn) which contains the address of a memory operand. After the operand is accessed, 1, 2, or 4 is added to the address register contents and the sum is stored in the address register. The value added is 1 for byte access, 2 for word access, or 4 for longword access. For word or longword access, the register value should be even.
- Register indirect with pre-decrement—@-ERn
The value 1, 2, or 4 is subtracted from an address register (ERn) specified by the register field in the instruction code, and the result becomes the address of a memory operand. The result is also stored in the address register. The value subtracted is 1 for byte access, 2 for word access, or 4 for longword access. For word or longword access, the register value should be even.

Absolute Address—@aa:8, @aa:16, @aa:24, or @aa:32: The instruction code contains the absolute address of a memory operand. The absolute address may be 8 bits long (@aa:8), 16 bits long (@aa:16), 24 bits long (@aa:24), or 32 bits long (@aa:32).

To access data, the absolute address should be 8 bits (@aa:8), 16 bits (@aa:16), or 32 bits (@aa:32) long. For an 8-bit absolute address, the upper 24 bits are all assumed to be 1 (H'FFFF). For a 16-bit absolute address the upper 16 bits are a sign extension. A 32-bit absolute address can access the entire address space.

A 24-bit absolute address (@aa:24) indicates the address of a program instruction. The upper 8 bits are all assumed to be 0 (H'00).

Table 2.5 indicates the accessible absolute address ranges.

Table 2.5 Absolute Address Access Ranges

| Absolute Address | | Normal Mode | Advanced Mode |
|-----------------------------|------------------|------------------|---|
| Data address | 8 bits (@aa:8) | H'FF00 to H'FFFF | H'FFF00 to H'FFFFFF |
| | 16 bits (@aa:16) | H'0000 to H'FFFF | H'000000 to H'007FFF, H'FF8000 to H'FFFFFF |
| | 32 bits (@aa:32) | | H'000000 to H'FFFFFF |
| Program instruction address | 24 bits (@aa:24) | | |

Immediate—**#xx:8, #xx:16, or #xx:32**: The instruction contains 8-bit (#xx:8), 16-bit (#xx:16), or 32-bit (#xx:32) immediate data as an operand.

The ADDS, SUBS, INC, and DEC instructions contain immediate data implicitly. Some bit manipulation instructions contain 3-bit immediate data in the instruction code, specifying a bit number. The TRAPA instruction contains 2-bit immediate data in its instruction code, specifying a vector address.

Program-Counter Relative—**@(d:8, PC) or @(d:16, PC)**: This mode is used in the Bcc and BSR instructions. An 8-bit or 16-bit displacement contained in the instruction is sign-extended and added to the 24-bit PC contents to generate a branch address. Only the lower 24 bits of this branch address are valid; the upper 8 bits are all assumed to be 0 (H'00). The PC value to which the displacement is added is the address of the first byte of the next instruction, so the possible branching range is -126 to $+128$ bytes (-63 to $+64$ words) or -32766 to $+32768$ bytes (-16383 to $+16384$ words) from the branch instruction. The resulting value should be an even number.

Memory Indirect—**@aa:8**: This mode can be used by the JMP and JSR instructions. The instruction code contains an 8-bit absolute address specifying a memory operand. This memory operand contains a branch address. The upper bits of the absolute address are all assumed to be 0, so the address range is 0 to 255 (H'0000 to H'00FF in normal mode, H'000000 to H'0000FF in advanced mode). In normal mode the memory operand is a word operand and the branch address is 16 bits long. In advanced mode the memory operand is a longword operand, the first byte of which is assumed to be all 0 (H'00).

Note that the first part of the address range is also the exception vector area. For further details, refer to section 4, Exception Handling.

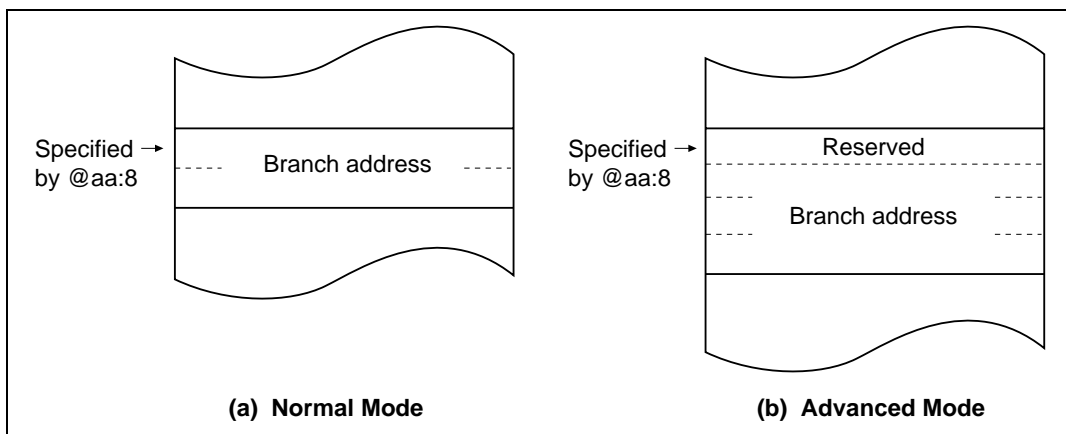


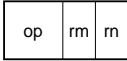
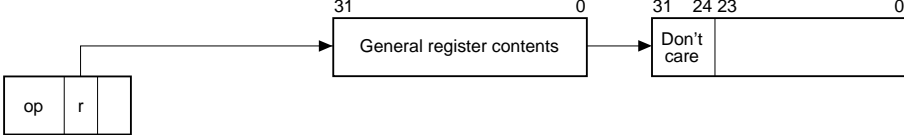
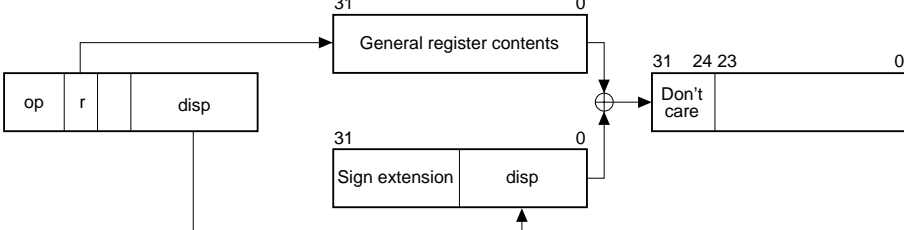
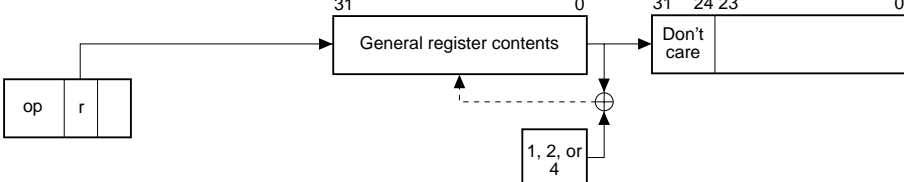
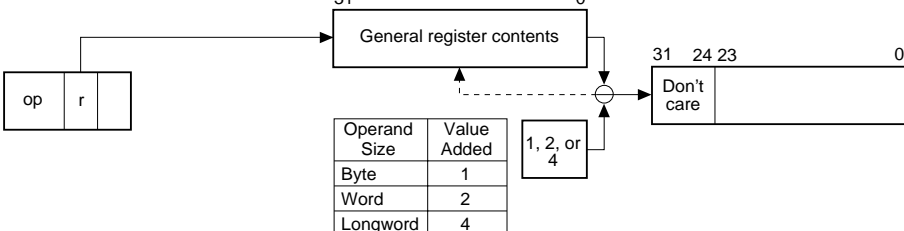
Figure 2.13 Branch Address Specification in Memory Indirect Mode

If an odd address is specified in word or longword memory access, or as a branch address, the least significant bit is regarded as 0, causing data to be accessed or an instruction code to be fetched at the address preceding the specified address. (For further information, see section 2.5.2, Memory Data Formats.)

2.7.2 Effective Address Calculation

Table 2.6 indicates how effective addresses are calculated in each addressing mode. In normal mode the upper 8 bits of the effective address are ignored in order to generate a 16-bit address.

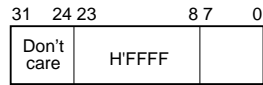
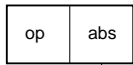
Table 2.6 Effective Address Calculation

| No. | Addressing Mode and Instruction Format | Effective Address Calculation | Effective Address (EA) | | | | | | | | |
|--------------|---|--|---------------------------------------|-------------|------|---|------|---|----------|---|--|
| 1 | Register direct (Rn)  | | Operand is general register contents. | | | | | | | | |
| 2 | Register indirect (@ERn) |  | | | | | | | | | |
| 3 | Register indirect with displacement @(d:16, ERn) or @(d:32, ERn) |  | | | | | | | | | |
| 4 | Register indirect with post-increment or pre-decrement • Register indirect with post-increment @ERn+ |  | | | | | | | | | |
| | • Register indirect with pre-decrement @-ERn |  <table border="1" data-bbox="491 1310 663 1422"> <thead> <tr> <th>Operand Size</th> <th>Value Added</th> </tr> </thead> <tbody> <tr> <td>Byte</td> <td>1</td> </tr> <tr> <td>Word</td> <td>2</td> </tr> <tr> <td>Longword</td> <td>4</td> </tr> </tbody> </table> | Operand Size | Value Added | Byte | 1 | Word | 2 | Longword | 4 | |
| Operand Size | Value Added | | | | | | | | | | |
| Byte | 1 | | | | | | | | | | |
| Word | 2 | | | | | | | | | | |
| Longword | 4 | | | | | | | | | | |

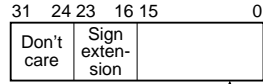
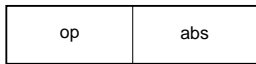
| No. | Addressing Mode and Instruction Format | Effective Address Calculation | Effective Address (EA) |
|-----|--|-------------------------------|------------------------|
|-----|--|-------------------------------|------------------------|

5 Absolute address

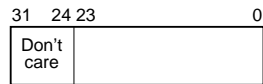
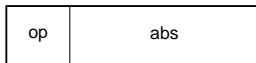
@aa:8



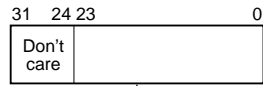
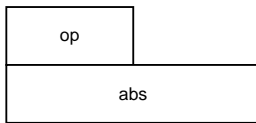
@aa:16



@aa:24

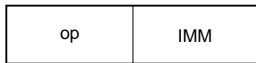


@aa:32



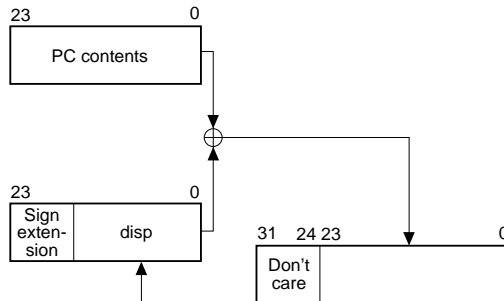
6 Immediate #xx:8/#xx:16/#xx:32

Operand is immediate data.



7 Program-counter relative

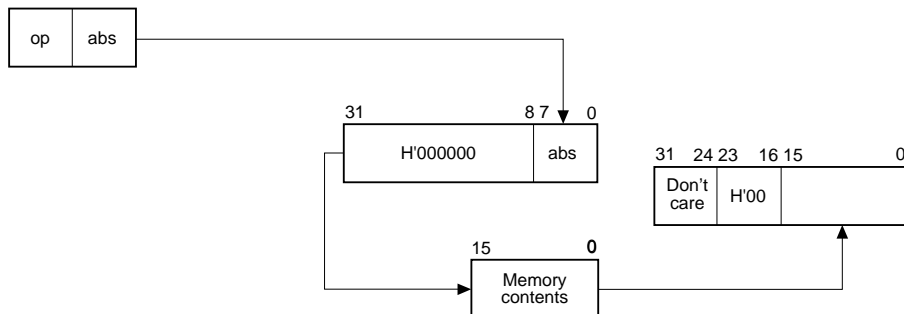
@(d:8, PC)/@(d:16, PC)



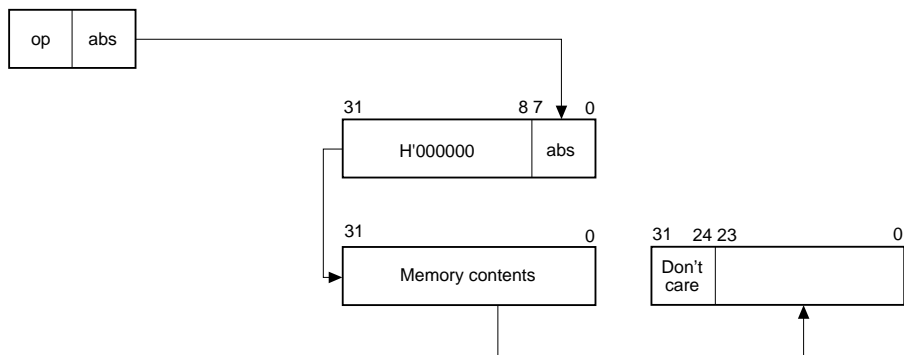
| No. | Addressing Mode and Instruction Format | Effective Address Calculation | Effective Address (EA) |
|-----|--|-------------------------------|------------------------|
|-----|--|-------------------------------|------------------------|

8 Memory indirect @@aa:8

- Normal mode



- Advanced mode



2.8 Processing States

2.8.1 Overview

The CPU has five main processing states: the reset state, exception-handling state, program execution state, bus-released state, and power-down state. Figure 2.14 shows a diagram of the processing states. Figure 2.15 indicates the state transitions.

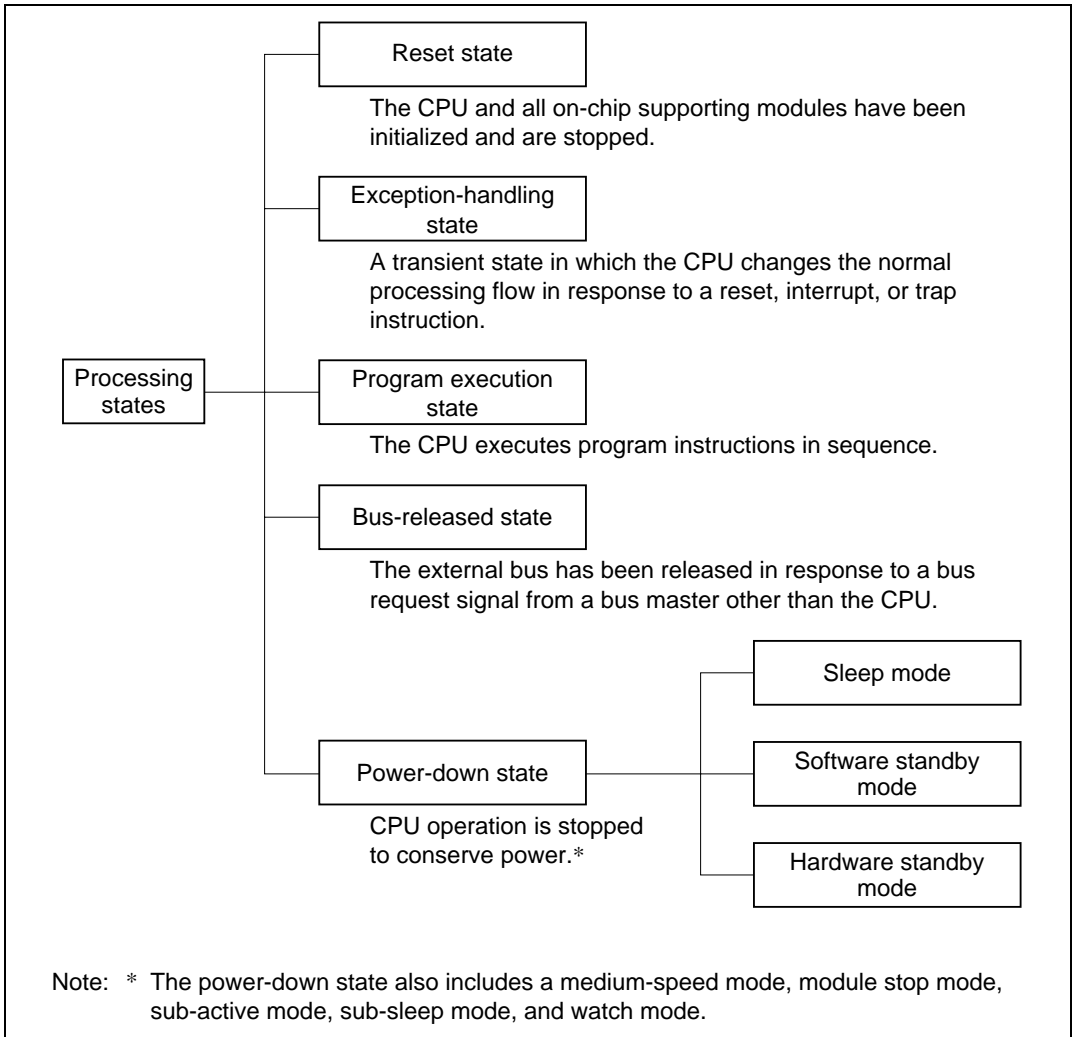


Figure 2.14 Processing States

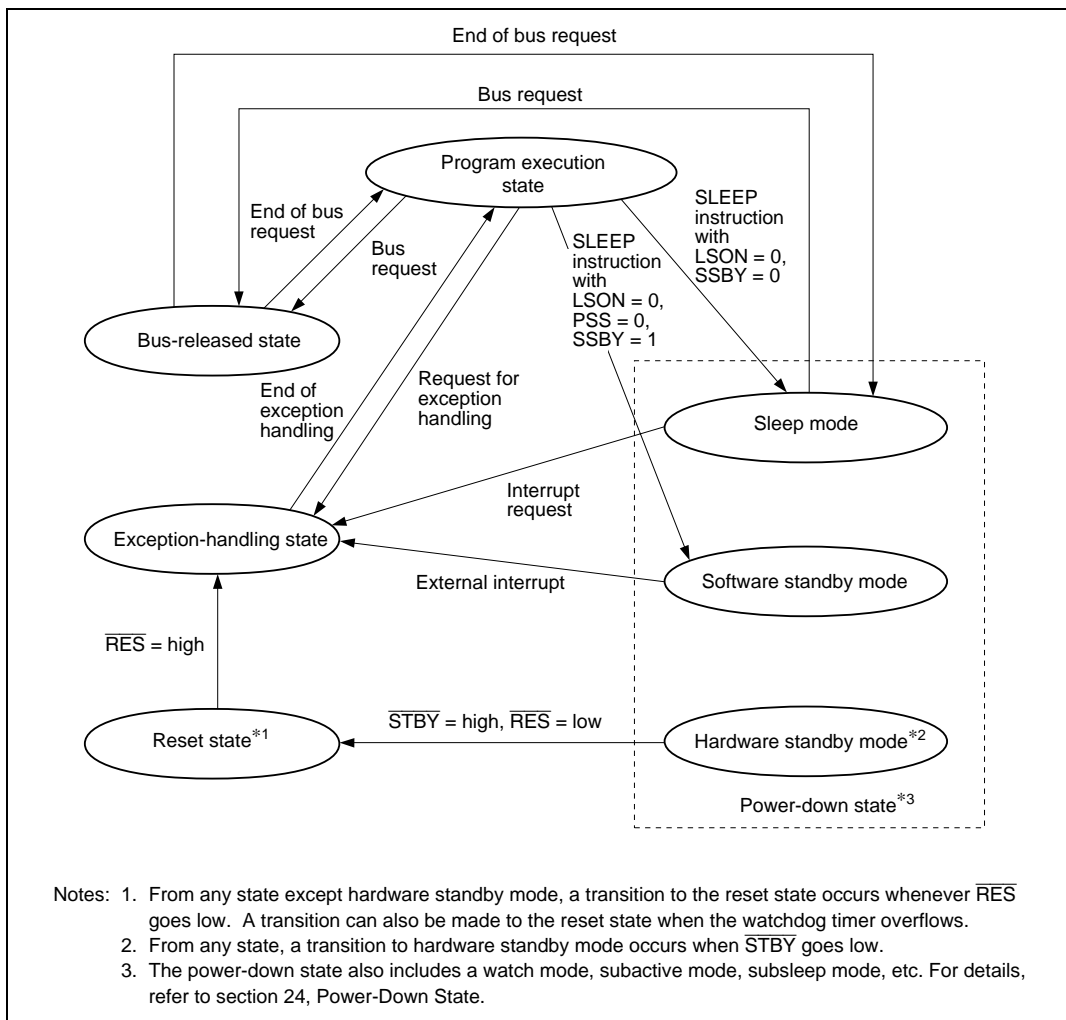


Figure 2.15 State Transitions

2.8.2 Reset State

When the \overline{RES} input goes low all current processing stops and the CPU enters the reset state. All interrupts are disabled in the reset state. Reset exception handling starts when the \overline{RES} signal changes from low to high.

The reset state can also be entered by a watchdog timer overflow. For details, refer to section 14, Watchdog Timer.

2.8.3 Exception-Handling State

The exception-handling state is a transient state that occurs when the CPU alters the normal processing flow due to a reset, interrupt, or trap instruction. The CPU fetches a start address (vector) from the exception vector table and branches to that address.

Types of Exception Handling and Their Priority: Exception handling is performed for resets, interrupts, and trap instructions. Table 2.7 indicates the types of exception handling and their priority. Trap instruction exception handling is always accepted in the program execution state.

Exception handling and the stack structure depend on the interrupt control mode set in SYSCR.

Table 2.7 Exception Handling Types and Priority

| Priority | Type of Exception | Detection Timing | Start of Exception Handling |
|------------------|-------------------|--|--|
| High ↑ Low | Reset | Synchronized with clock | Exception handling starts immediately after a low-to-high transition at the $\overline{\text{RES}}$ pin, or when the watchdog timer overflows. |
| | Interrupt | End of instruction execution or end of exception-handling sequence ^{*1} | When an interrupt is requested, exception handling starts at the end of the current instruction or current exception-handling sequence. |
| | Trap instruction | When TRAPA instruction is executed | Exception handling starts when a trap (TRAPA) instruction is executed. ^{*2} |

Notes: 1. Interrupts are not detected at the end of the ANDC, ORC, XORC, and LDC instructions, or immediately after reset exception handling.

2. Trap instruction exception handling is always accepted in the program execution state.

Reset Exception Handling: After the $\overline{\text{RES}}$ pin has gone low and the reset state has been entered, when $\overline{\text{RES}}$ goes high again, reset exception handling starts. When reset exception handling starts the CPU fetches a start address (vector) from the exception vector table and starts program execution from that address. All interrupts, including NMI, are disabled during reset exception handling and after it ends.

Interrupt Exception Handling and Trap Instruction Exception Handling: When interrupt or trap-instruction exception handling begins, the CPU references the stack pointer (ER7) and pushes the program counter and other control registers onto the stack. Next, the CPU alters the settings of the interrupt mask bits in the control registers. Then the CPU fetches a start address (vector) from the exception vector table and program execution starts from that start address.

Figure 2.16 shows the stack after exception handling ends.

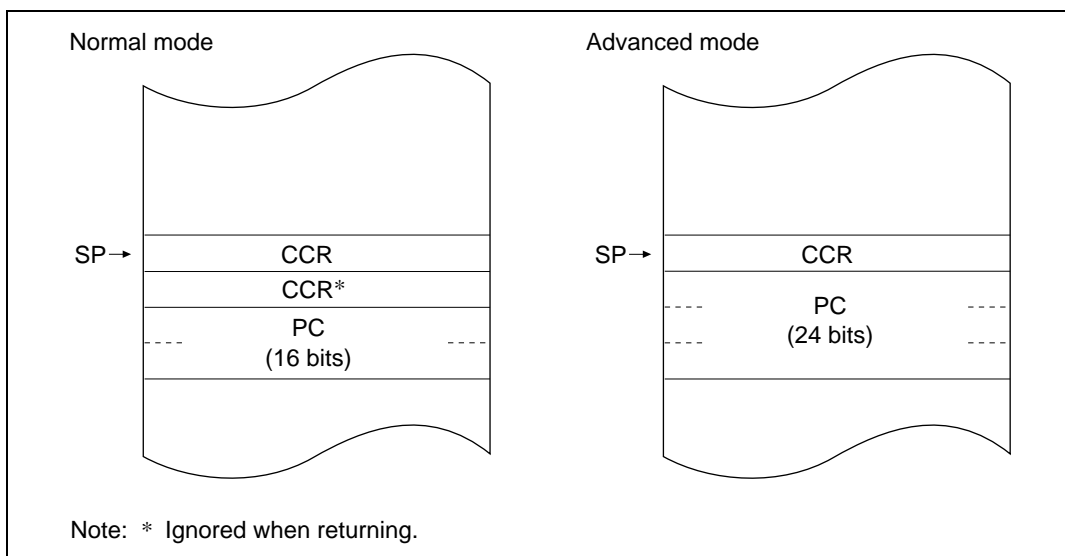


Figure 2.16 Stack Structure after Exception Handling (Examples)

2.8.4 Program Execution State

In this state the CPU executes program instructions in sequence.

2.8.5 Bus-Released State

This is a state in which the bus has been released in response to a bus request from a bus master other than the CPU. While the bus is released, the CPU halts except for internal operations.

There is one other bus master in addition to the CPU: the data transfer controller (DTC).

For further details, refer to section 6, Bus Controller.

2.8.6 Power-Down State

The power-down state includes both modes in which the CPU stops operating and modes in which the CPU does not stop. There are five modes in which the CPU stops operating: sleep mode, software standby mode, hardware standby mode, subsleep mode, and watch mode. There are also three other power-down modes: medium-speed mode, module stop mode, and subactive mode. In medium-speed mode, the CPU and other bus masters operate on a medium-speed clock. Module

stop mode permits halting of the operation of individual modules, other than the CPU. Subactive mode, subsleep mode, and watch mode are power-down modes that use subclock input. For details, refer to section 24, Power-Down State.

Sleep Mode: A transition to sleep mode is made if the SLEEP instruction is executed while the software standby bit (SSBY) in the standby control register (SBYCR) and the LSON bit in the low-power control register (LPWRCR) are both cleared to 0. In sleep mode, CPU operations stop immediately after execution of the SLEEP instruction. The contents of CPU registers are retained.

Software Standby Mode: A transition to software standby mode is made if the SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1 and the LSON bit in LPWRCR and the PSS bit in the WDT1 timer control/status register (TCSR) are both cleared to 0. In software standby mode, the CPU and clock halt and all MCU operations stop. As long as a specified voltage is supplied, the contents of CPU registers and on-chip RAM are retained. The I/O ports also remain in their existing states.

Hardware Standby Mode: A transition to hardware standby mode is made when the $\overline{\text{STBY}}$ pin goes low. In hardware standby mode, the CPU and clock halt and all MCU operations stop. The on-chip supporting modules are reset, but as long as a specified voltage is supplied, on-chip RAM contents are retained.

2.9 Basic Timing

2.9.1 Overview

The CPU is driven by a system clock, denoted by the symbol ϕ . The period from one rising edge of ϕ to the next is referred to as a “state.” The memory cycle or bus cycle consists of one, two, or three states. Different methods are used to access on-chip memory, on-chip supporting modules, and the external address space.

2.9.2 On-Chip Memory (ROM, RAM)

On-chip memory is accessed in one state. The data bus is 16 bits wide, permitting both byte and word transfer instruction. Figure 2.17 shows the on-chip memory access cycle. Figure 2.18 shows the pin states.

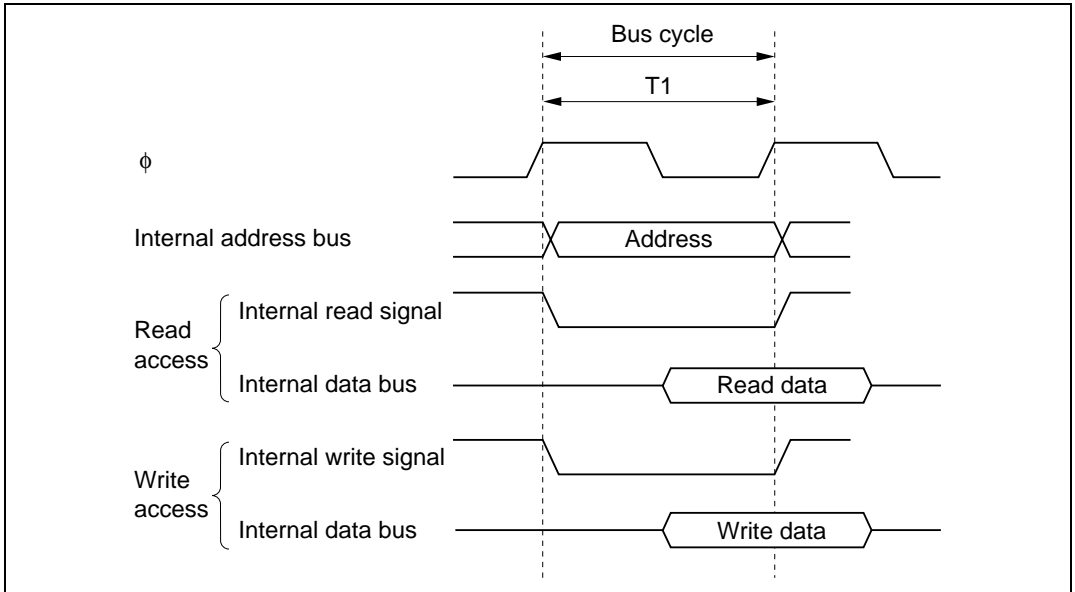


Figure 2.17 On-Chip Memory Access Cycle

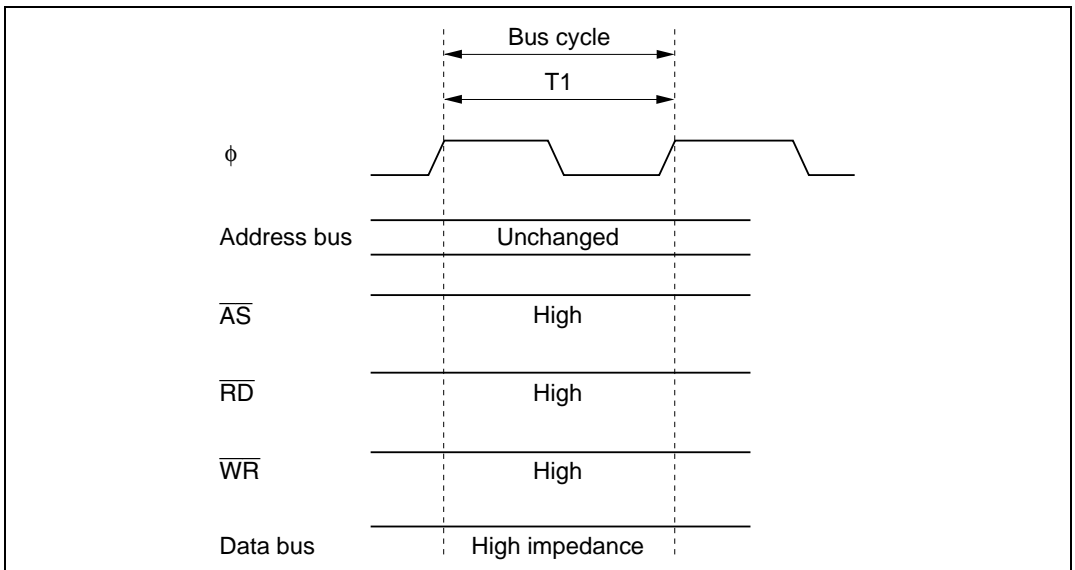


Figure 2.18 Pin States during On-Chip Memory Access

2.9.3 On-Chip Supporting Module Access Timing

The on-chip supporting modules are accessed in two states. The data bus is either 8 bits or 16 bits wide, depending on the particular internal I/O register being accessed. Figure 2.19 shows the access timing for the on-chip supporting modules. Figure 2.20 shows the pin states.

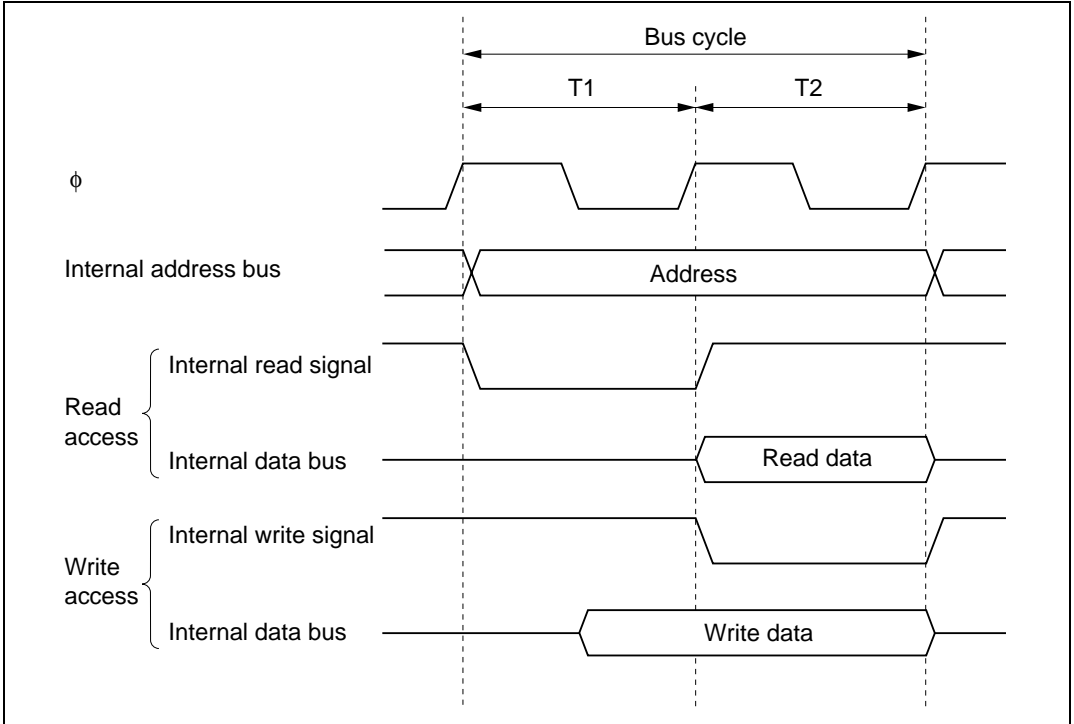


Figure 2.19 On-Chip Supporting Module Access Cycle

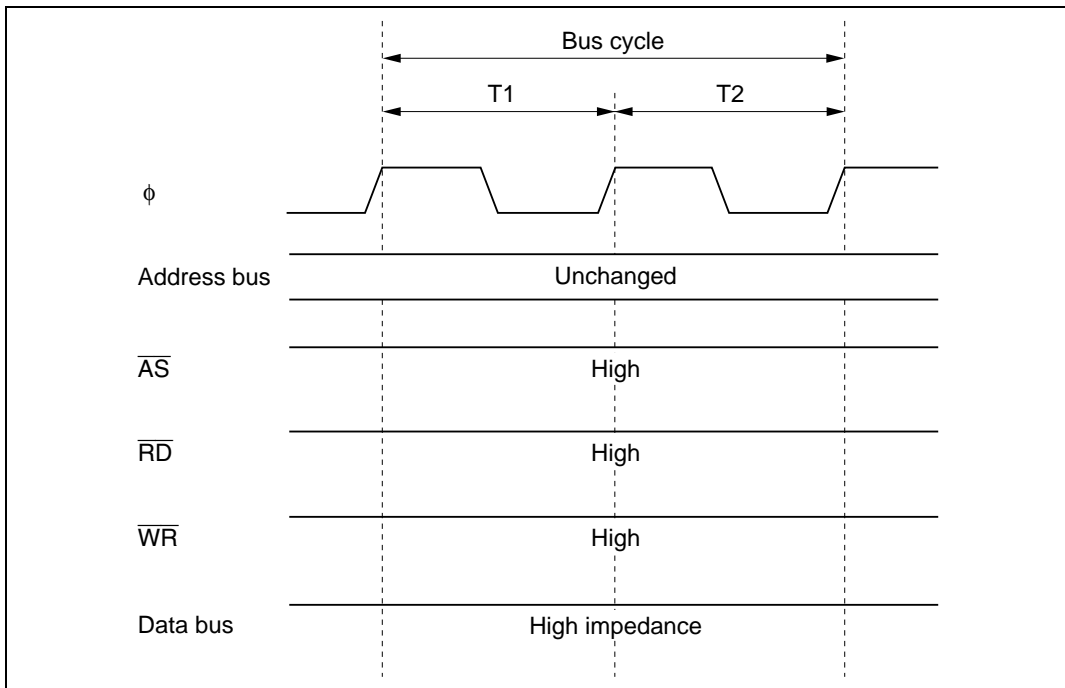


Figure 2.20 Pin States during On-Chip Supporting Module Access

2.9.4 External Address Space Access Timing

The external address space is accessed with an 8-bit data bus width in a two-state or three-state bus cycle. In three-state access, wait states can be inserted. For further details, refer to section 6, Bus Controller.

2.10 Usage Note

2.10.1 TAS Instruction

Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction. The TAS instruction is not generated by the Renesas H8S and H8/300 series C/C++ compilers. If the TAS instruction is used as a user-defined intrinsic function, ensure that only register ER0, ER1, ER4, or ER5 is used.

2.10.2 STM/LDM Instruction

ER7 is not used as the register that can be saved (STM)/restored (LDM) when using STM/LDM instruction, because ER7 is the stack pointer. Two, three, or four registers can be saved/restored by one STM/LDM instruction. The following ranges can be specified in the register list.

Two registers: ER0–ER1, ER2–ER3, or ER4–ER5

Three registers: ER0–ER2, or ER4–ER6

Four registers: ER0–ER3

The STM/LDM instruction including ER7 is not generated by the Renesas H8S and H8/300 series C/C++ compilers.

Section 3 MCU Operating Modes

3.1 Overview

3.1.1 Operating Mode Selection

The H8S/2138 Group and H8S/2134 Group have three operating modes (modes 1 to 3). These modes enable selection of the CPU operating mode and enabling/disabling of on-chip ROM, by setting the mode pins (MD1 and MD0).

Table 3.1 lists the MCU operating modes.

Table 3.1 MCU Operating Mode Selection

| MCU Operating Mode | MD1 | MD0 | CPU Operating Mode | Description | On-Chip ROM |
|--------------------|-----|-----|--------------------|--|-------------|
| 0 | 0 | 0 | — | — | — |
| 1 | | 1 | Normal | Expanded mode with on-chip ROM disabled | Disabled |
| 2 | 1 | 0 | Advanced | Expanded mode with on-chip ROM enabled Single-chip mode | Enabled |
| 3 | | 1 | Normal | Expanded mode with on-chip ROM enabled Single-chip mode | |

The CPU's architecture allows for 4 Gbytes of address space, but the H8S/2138 Group and H8S/2134 Group actually access a maximum of 16 Mbytes. However, as there are 16 external address output pins, advanced mode is enabled only in single-chip mode or in expanded mode with on-chip ROM enabled when a specific area in the external address space is accessed using IOS. The external data bus width is 8 bits.

Mode 1 is an externally expanded mode that allows access to external memory and peripheral devices. With modes 2 and 3, operation begins in single-chip mode after reset release, but a transition can be made to external expansion mode by setting the EXPE bit in MDCR.

The H8S/2138 Group and H8S/2134 Group can only be used in modes 1 to 3. These means that the mode pins must select one of these modes. Do not changes the inputs at the mode pins during operation.

3.1.2 Register Configuration

The H8S/2138 Group and H8S/2134 Group have a mode control register (MDCR) that indicates the inputs at the mode pins (MD1 and MD0), a system control register (SYSCR) and bus control register (BCR) that control the operation of the MCU, and a serial timer control register (STCR) that controls the operation of the supporting modules. Table 3.2 summarizes these registers.

Table 3.2 MCU Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|-------------------------------|--------------|-----|---------------|----------|
| Mode control register | MDCR | R/W | Undetermined | H'FFC5 |
| System control register | SYSCR | R/W | H'09 | H'FFC4 |
| Bus control register | BCR | R/W | H'D7 | H'FFC6 |
| Serial timer control register | STCR | R/W | H'00 | H'FFC3 |

Note: * Lower 16 bits of the address.

3.2 Register Descriptions

3.2.1 Mode Control Register (MDCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|------|------|
| | EXPE | — | — | — | — | — | MDS1 | MDS0 |
| Initial value | —* | 0 | 0 | 0 | 0 | 0 | —* | —* |
| Read/Write | R/W* | — | — | — | — | — | R | R |

Note: * Determined by pins MD1 and MD0.

MDCR is an 8-bit read-only register that indicates the operating mode setting and the current operating mode of the MCU.

The EXPE bit is initialized in coordination with the mode pin states by a reset and in hardware standby mode.

Bit 7—Expanded Mode Enable (EXPE): Sets expanded mode. In mode 1, this bit is fixed at 1 and cannot be modified. In modes 2 and 3, this bit has an initial value of 0, and can be read and written.

Bit 7

| EXPE | Description |
|------|------------------------------|
| 0 | Single chip mode is selected |
| 1 | Expanded mode is selected |

Bits 6 to 2—Reserved: These bits cannot be modified and are always read as 0.

Bits 1 and 0—Mode Select 1 and 0 (MDS1, MDS0): These bits indicate the input levels at pins MD1 and MD0 (the current operating mode). Bits MDS1 and MDS0 correspond to MD1 and MD0. MDS1 and MDS0 are read-only bits—they cannot be written to. The mode pin (MD1 and MD0) input levels are latched into these bits when MDCR is read.

3.2.2 System Control Register (SYSCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|------|-------|-----|------|
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

SYSCR is an 8-bit readable/writable register that performs selection of system pin functions, reset source monitoring, interrupt control mode selection, NMI detected edge selection, supporting module pin location selection, supporting module register access control, and RAM address space control.

Only bits 7, 6, 3, 1, and 0 are described here. For a detailed description of these bits, refer also to the description of the relevant modules (host interface, bus controller, watchdog timer, RAM, etc.). For information on bits 5, 4, and 2, see section 5.2.1, System Control Register (SYSCR).

SYSCR is initialized to H'09 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Chip Select 2 Enable (CS2E): Specifies the location of the host interface control pin (CS₂). For details, see section 17, Host Interface. The H8S/2134 Group does not incorporate a host interface, so do not set this bit to 1 in the H8S/2134 Group.

Bit 6—IOS Enable (IOSE): Controls the function of the $\overline{AS}/\overline{IOS}$ pin in expanded mode.

Bit 6

| IOSE | Description |
|------|---|
| 0 | The $\overline{AS}/\overline{IOS}$ pin functions as the address strobe pin (\overline{AS}) (Low output when accessing an external area) (Initial value) |
| 1 | The $\overline{AS}/\overline{IOS}$ pin functions as the I/O strobe pin (\overline{IOS}) (Low output when accessing a specified address from H'(FF)F000 to H'(FF)FE4F)* |

Note: * In the H8S/2138 F-ZTAT A-mask version, the address range is from H'(FF)F000 to H'(FF)F7FF.

Bit 3—External Reset (XRST): Indicates the reset source. When the watchdog timer is used, a reset can be generated by watchdog timer overflow as well as by external reset input. XRST is a read-only bit. It is set to 1 by an external reset and cleared to 0 by watchdog timer overflow.

Bit 3

| XRST | Description |
|------|---|
| 0 | A reset is generated by watchdog timer overflow |
| 1 | A reset is generated by an external reset (Initial value) |

Bit 1—Host Interface Enable (HIE): This bit controls CPU access to the host interface data registers and control registers (HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2), the keyboard controller and MOS input pull-up control registers (KMIMR and KMPCR), the 8-bit timer (channel X and Y) data registers and control registers (TCRX/TCRY, TCSRX/TCSRY, TICRR/TCORAY, TICRF/TCORBY, TCNTX/TCNTY, TCORC/TISR, TCORAX, and TCORBX), and the timer connection control registers (TCONRI, TCONRO, TCONRS, and SEDGR).

Bit 1

| HIE | Description |
|-----|--|
| 0 | In areas H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF, CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers, is permitted (Initial value) |
| 1 | In areas H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF, CPU access to host interface data registers and control registers, and keyboard controller and MOS input pull-up control registers, is permitted |

Bit 0—RAM Enable (RAME): Enables or disables the on-chip RAM. The RAME bit is initialized when the reset state is released. It is not initialized in software standby mode.

Bit 0

| RAME | Description |
|------|--|
| 0 | On-chip RAM is disabled |
| 1 | On-chip RAM is enabled (Initial value) |

3.2.3 Bus Control Register (BCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|--------|--------|--------|-----|------|------|
| | ICIS1 | ICIS0 | BRSTRM | BRSTS1 | BRSTS0 | — | IOS1 | IOS0 |
| Initial value | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

BCR is an 8-bit readable/writable register that specifies the external memory space access mode, and the I/O area range when the \overline{AS} pin is designated for use as the I/O strobe. For details on bits 7 to 2, see section 6.2.1, Bus Control Register (BCR).

BCR is initialized to H'D7 by a reset and in hardware standby mode.

Bits 1 and 0—IOS Select 1 and 0 (IOS1, IOS0): These bits specify the addresses for which the $\overline{AS}/\overline{IOS}$ pin output goes low when IOSE = 1.

| BCR | | |
|-------|-------|---|
| Bit 1 | Bit 0 | |
| IOS1 | IOS0 | Description |
| 0 | 0 | The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)F03F |
| | 1 | The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)F0FF |
| 1 | 0 | The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)F3FF |
| | 1 | The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)FE4F* (Initial value) |

Note: * In the H8S/2138 F-ZTAT A-mask version, the address range is from H'(FF)F000 to H'(FF)F7FF.

3.2.4 Serial Timer Control Register (STCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-------|-------|------|-------|-----|-------|-------|
| | — | IICX1 | IICX0 | IICE | FLSHE | — | ICKS1 | ICKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), an on-chip flash memory control (in F-ZTAT versions), and also selects the TCNT input clock. For details of functions other than register access control, see the descriptions of the relevant modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Reserved: Do not write 1 to this bit.

Bits 6 and 5—I²C Transfer Select (IICX1, IICX0): These bits control the operation of the I²C bus interface when the on-chip IIC option is included. For details, see section 16.2.7, Serial Timer Control Register (STCR).

Bit 4—I²C Master Enable (IICE): Controls CPU access to the I²C bus interface data registers and control registers (ICCR, ICSR, ICDR/SARX, and ICMR/SAR), the PWMX data registers and control registers (DADRAH/DACR, DADRAL, DADRBH/DACNTH, and DADRBL/DACNTL), and the SCI control registers (SMR, BRR, and SCMR).

Bit 4

| IICE | Description |
|-------------|---|
| 0 | Addresses H'(FF)FF88 and H'(FF)FF89, and H'(FF)FF8E and H'(FF)FF8F, are used for SCI1 control register access (Initial value) Addresses H'(FF)FFA0 and H'(FF)FFA1, and H'(FF)FFA6 and H'(FF)FFA7, are used for SCI2 control register access Addresses H'(FF)FFD8 and H'(FF)FFD9, and H'(FF)FFDE and H'(FF)FFDF, are used for SCI0 control register access |
| 1 | Addresses H'(FF)FF88 and H'(FF)FF89, and H'(FF)FF8E and H'(FF)FF8F, are used for IIC1 data register and control register access Addresses H'(FF)FFA0 and H'(FF)FFA1, and H'(FF)FFA6 and H'(FF)FFA7, are used for PWMX data register and control register access Addresses H'(FF)FFD8 and H'(FF)FFD9, and H'(FF)FFDE and H'(FF)FFDF, are used for IIC0 data register and control register access |

Bit 3—Flash Memory Control Register Enable (FLSHE): Controls CPU access to the flash memory control registers (FLMCR1, FLMCR2, EBR1, and EBR2), the power-down mode control registers (SBYCR, LPWRCR, MSTPCRH, and MSTPCRL), and the supporting module control registers (PCSR and SYSCR2).

Bit 3

| FLSHE | Description |
|--------------|--|
| 0 | Addresses H'(FF)FF80 to H'(FF)FF87 are used for power-down mode control register and supporting module control register access (Initial value) |
| 1 | Addresses H'(FF)FF80 to H'(FF)FF87 are used for flash memory control register access (F-ZTAT version only) |

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits, together with bits CKS2 to CKS0 in TCR, select the clock to be input to TCNT. For details, see section 12.2.4, Timer Control Register (TCR).

3.3 Operating Mode Descriptions

3.3.1 Mode 1

The CPU can access a 64-kbyte address space in normal mode. The on-chip ROM is disabled.

Ports 1 and 2 function as an address bus, port 3 function as a data bus, and part of port 9 carries bus control signals.

3.3.2 Mode 2

The CPU can access a 16-Mbyte address space in advanced mode. The on-chip ROM is enabled. After a reset, single-chip mode is set, and the EXPE bit in MDCR must be set to 1 in order to use external addresses. However, as these groups have a maximum of 16 address outputs, an external address can be specified correctly only when the I/O strobe function of the $\overline{AS}/\overline{IOS}$ pin is used.

When the EXPE bit in MDCR is set to 1, ports 1 and 2 function as input ports after a reset. They can be set to output addresses by setting the corresponding bits in the data direction register (DDR) to 1. Port 3 function as a data bus, and part of port 9 carries bus control signals.

3.3.3 Mode 3

The CPU can access a 64-kbyte address space in normal mode. The on-chip ROM is enabled. After a reset, single-chip mode is set, and the EXPE bit in MDCR must be set to 1 in order to use external addresses.

When the EXPE bit in MDCR is set to 1, ports 1 and 2 function as input ports after a reset. They can be set to output addresses by setting the corresponding bits in the data direction register (DDR) to 1. Port 3 function as a data bus, and part of port 9 carries bus control signals.

In products with an on-chip ROM capacity of 64 kbytes or more, the amount of on-chip ROM that can be used is limited to 56 kbytes.

3.4 Pin Functions in Each Operating Mode

The pin functions of ports 1 to 3, and 9 vary depending on the operating mode. Table 3.3 shows their functions in each operating mode.

Table 3.3 Pin Functions in Each Mode

| Port | Mode 1 | Mode 2 | Mode 3 |
|--------|------------|--------|--------|
| Port 1 | A | P*/A | P*/A |
| Port 2 | A | P*/A | P*/A |
| Port 3 | D | P*/D | P*/D |
| Port 9 | P97 | P*/C | P*/C |
| | P96 | C*/P | P*/C |
| | P95 to P93 | C | P*/C |
| | P92 to P90 | P | P |

Legend:

P: I/O port

A: Address bus output

D: Data bus I/O

C: Control signals, clock I/O

*: After reset

3.5 Memory Map in Each Operating Mode

Figures 3.1 to 3.4 show memory maps for each of the operating modes.

The address space is 64 kbytes in modes 1 and 3 (normal modes), and 16 Mbytes in mode 2 (advanced mode).

The on-chip ROM capacity is 32 kbytes (H8S/2130), 64 kbytes (H8S/2132 and H8S/2137), 96 kbytes (H8S/2133), or 128 kbytes (H8S/2134 and H8S/2138), but for products with an on-chip ROM capacity of 64 kbytes or more, the amount of on-chip ROM that can be used is limited to 56 kbytes in mode 3 (normal mode). Do not access the reserved area and addresses of modules not supported by the product. Note that normal operation is not guaranteed when these regions are accessed.

For details, see section 6, Bus Controller.

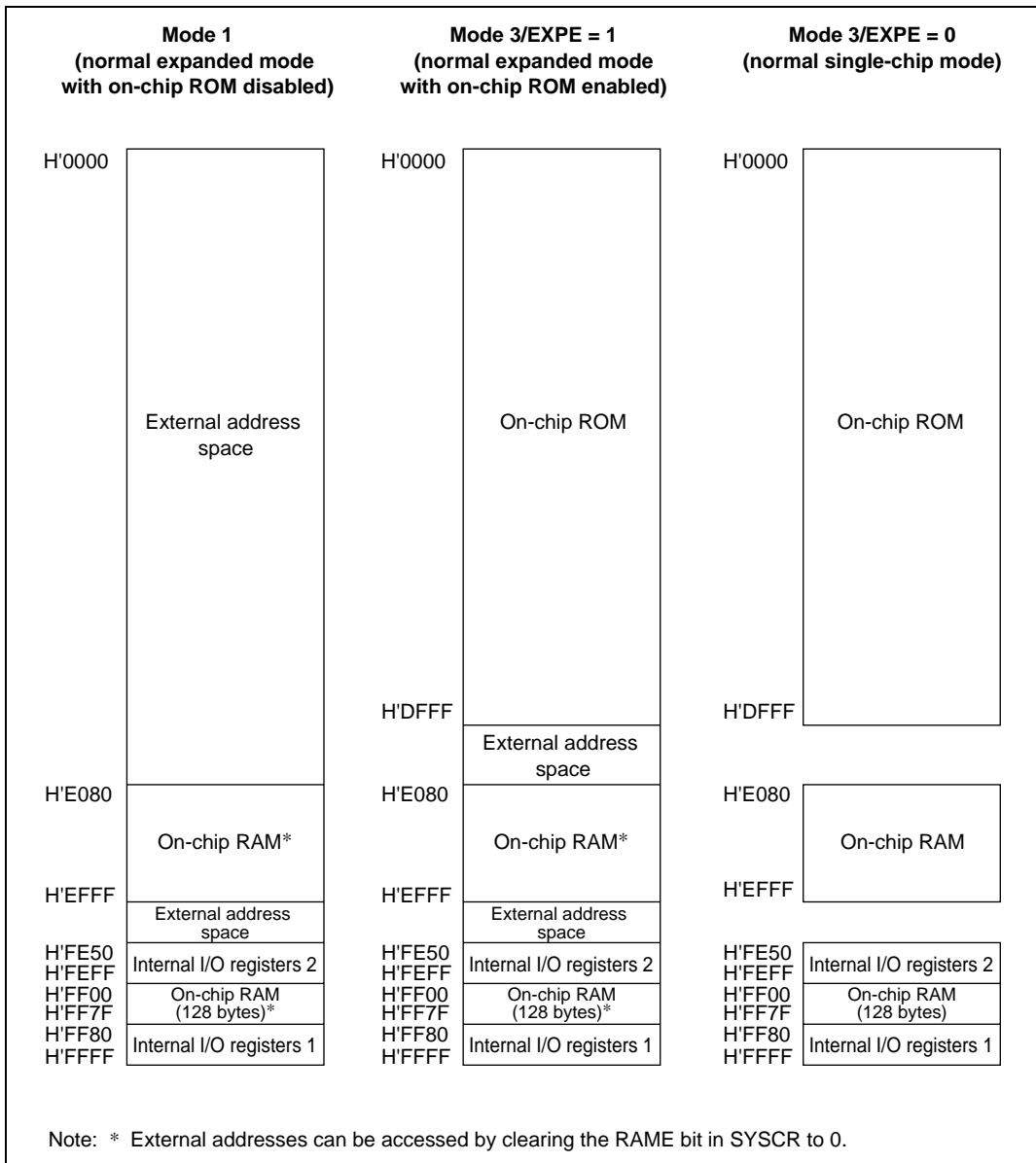


Figure 3.1 H8S/2138 (Except for F-ZTAT A-Mask Version) and H8S/2134 Memory Map in Each Operating Mode

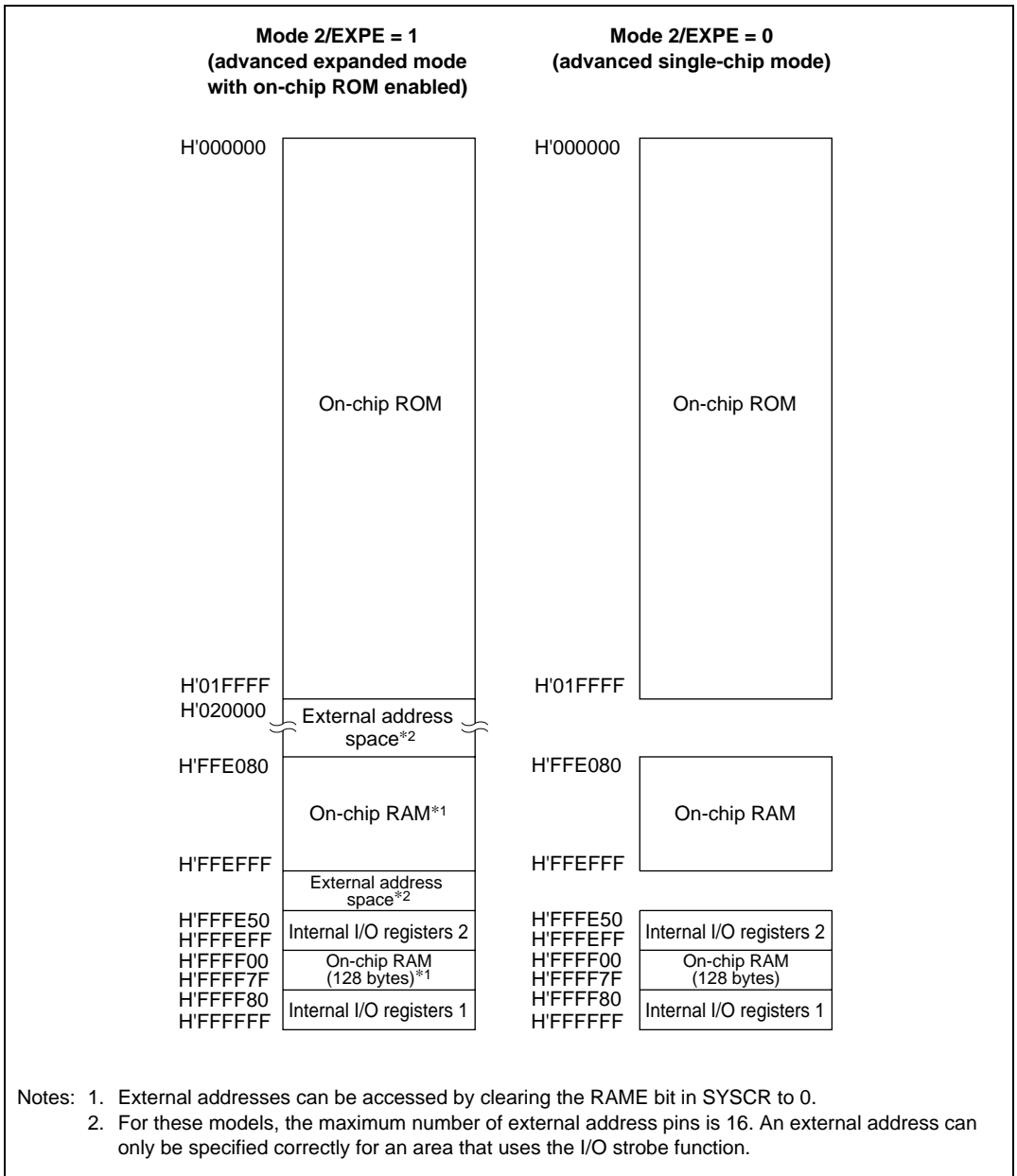


Figure 3.1 H8S/2138 (Except for F-ZTAT A-Mask Version) and H8S/2134 Memory Map in Each Operating Mode (cont)

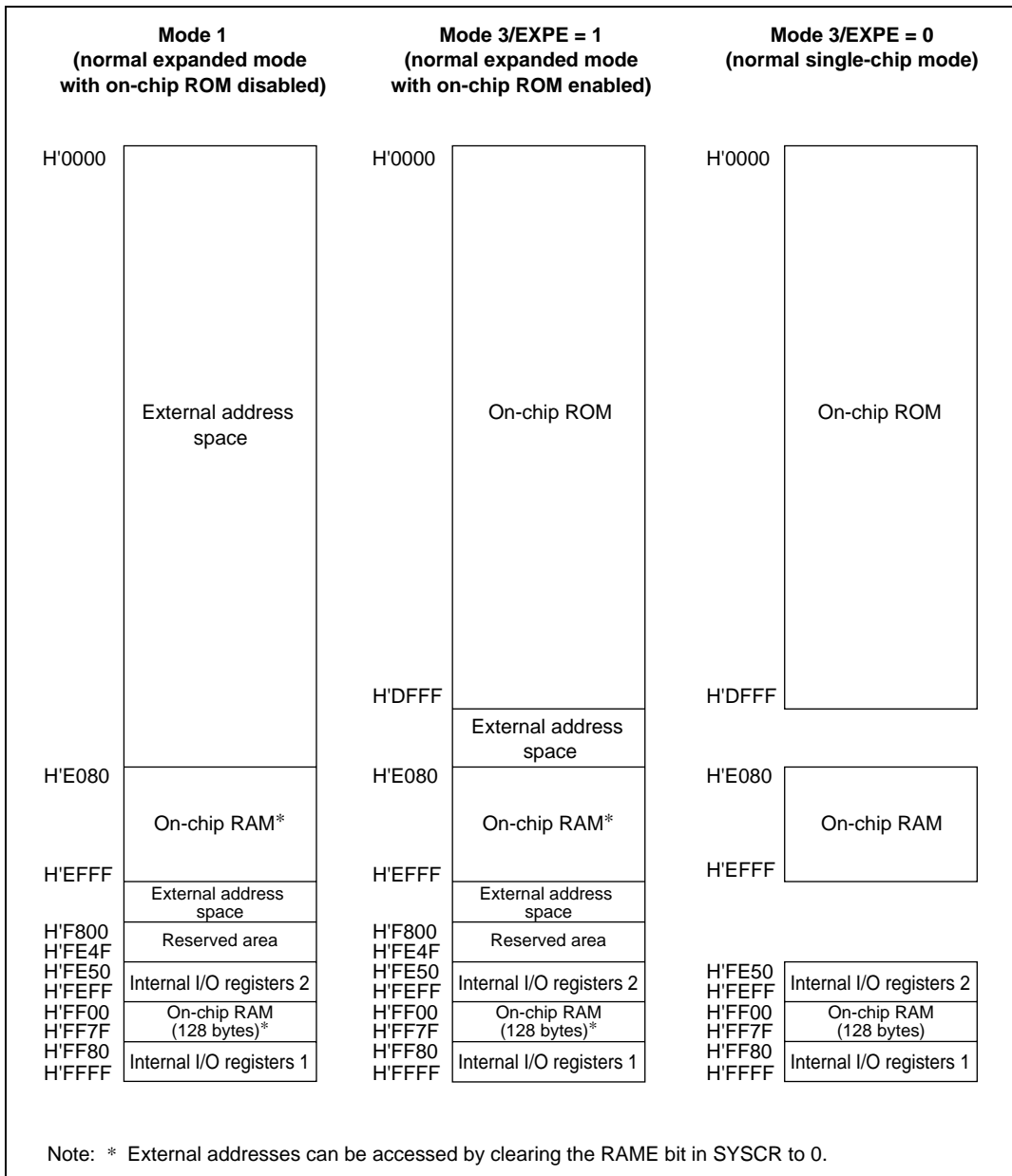


Figure 3.2 H8S/2138 F-ZTAT A-Mask Version Memory Map in Each Operating Mode

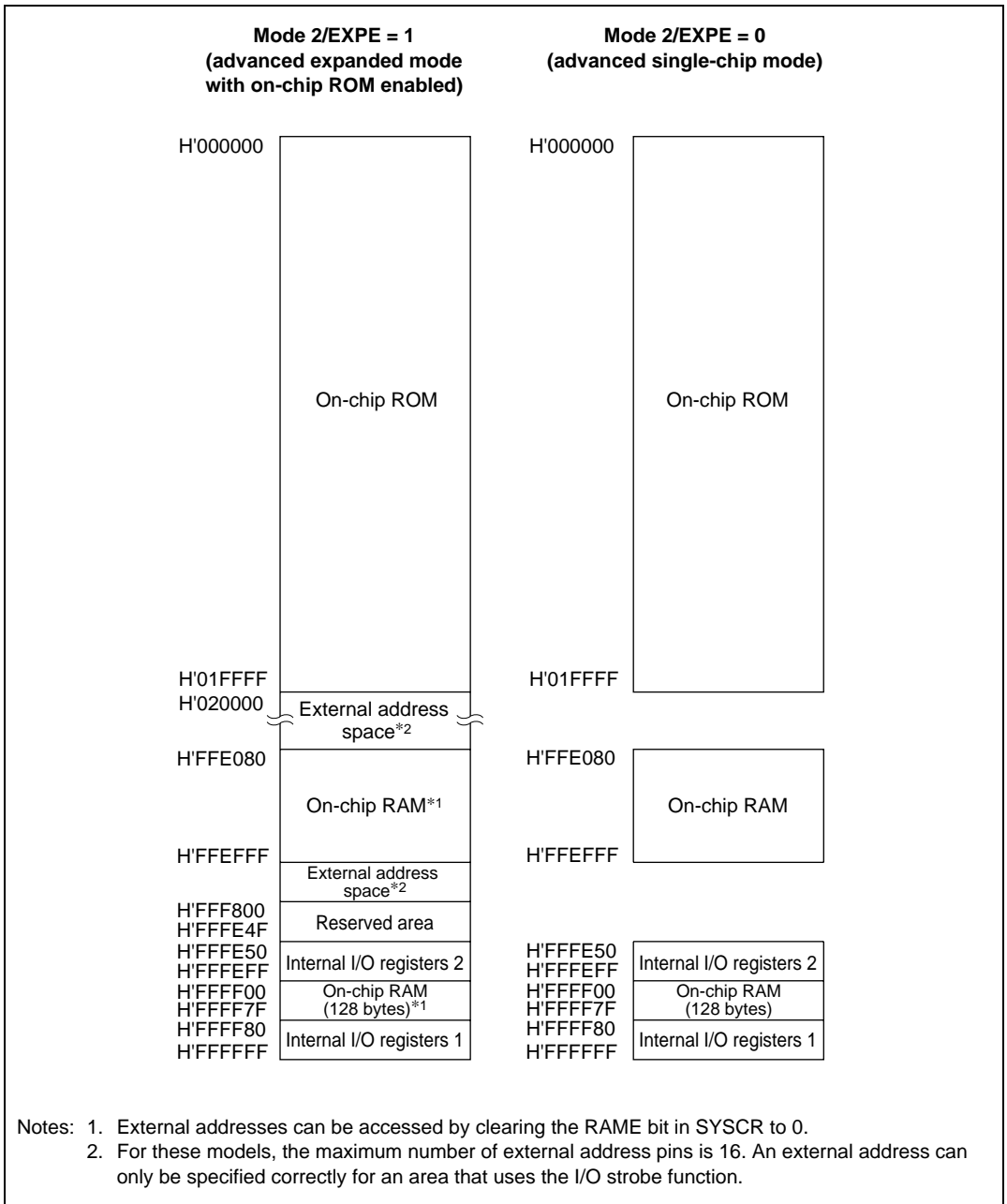


Figure 3.2 H8S/2138 F-ZTAT A-Mask Version Memory Map in Each Operating Mode (cont)

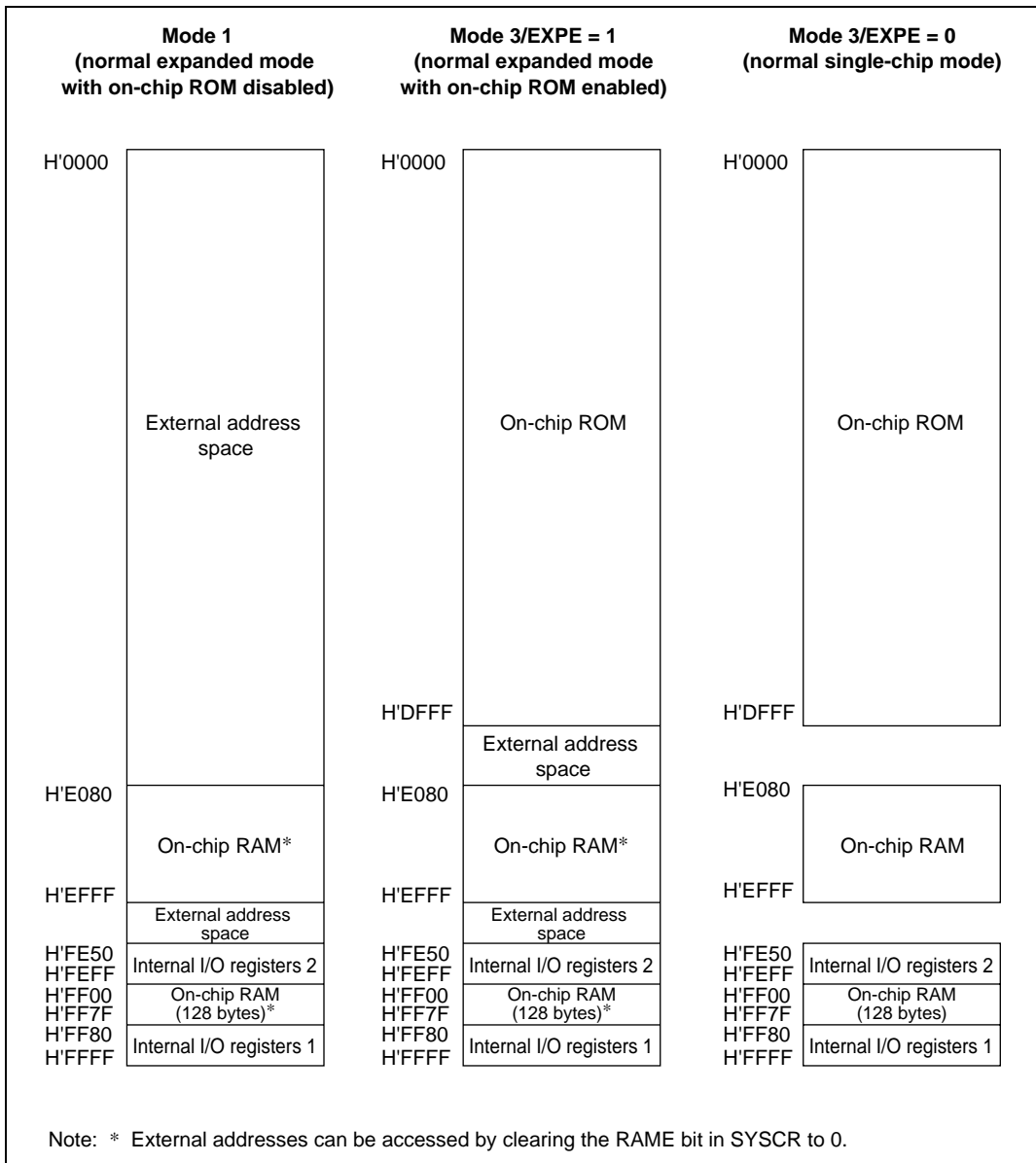


Figure 3.3 H8S/2133 Memory Map in Each Operating Mode

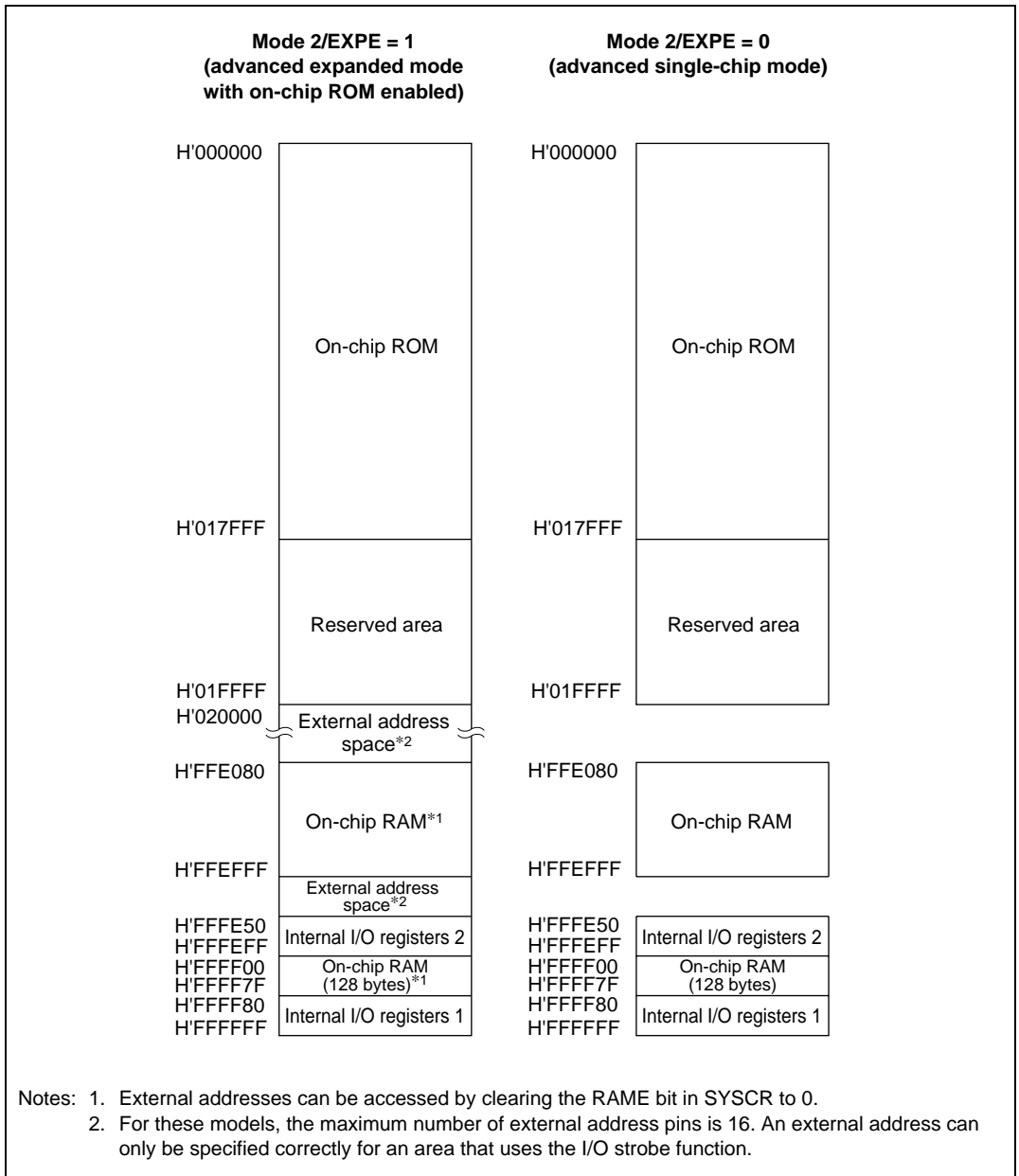


Figure 3.3 H8S/2133 Memory Map in Each Operating Mode (cont)

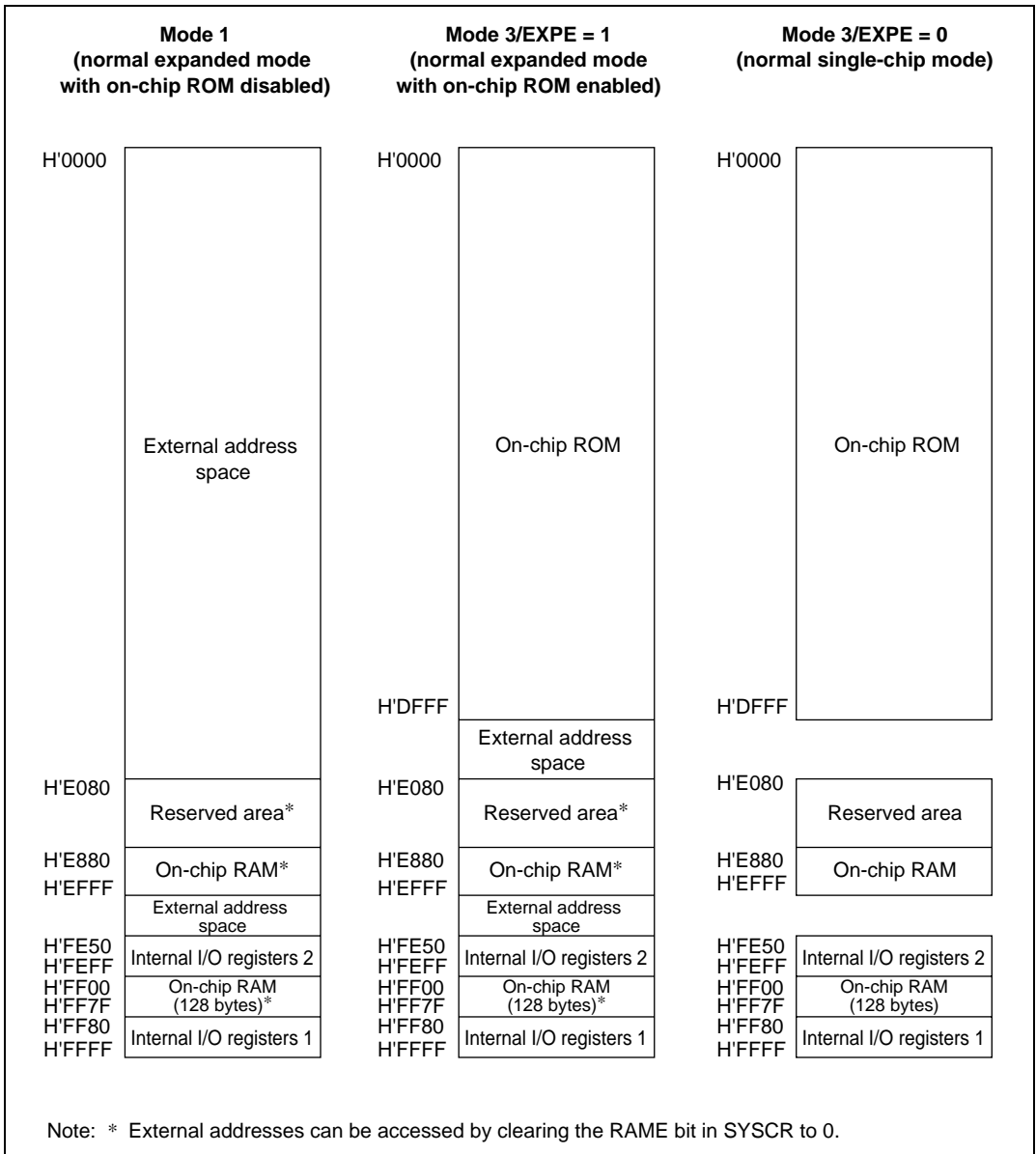


Figure 3.4 H8S/2137 and H8S/2132 Memory Map in Each Operating Mode

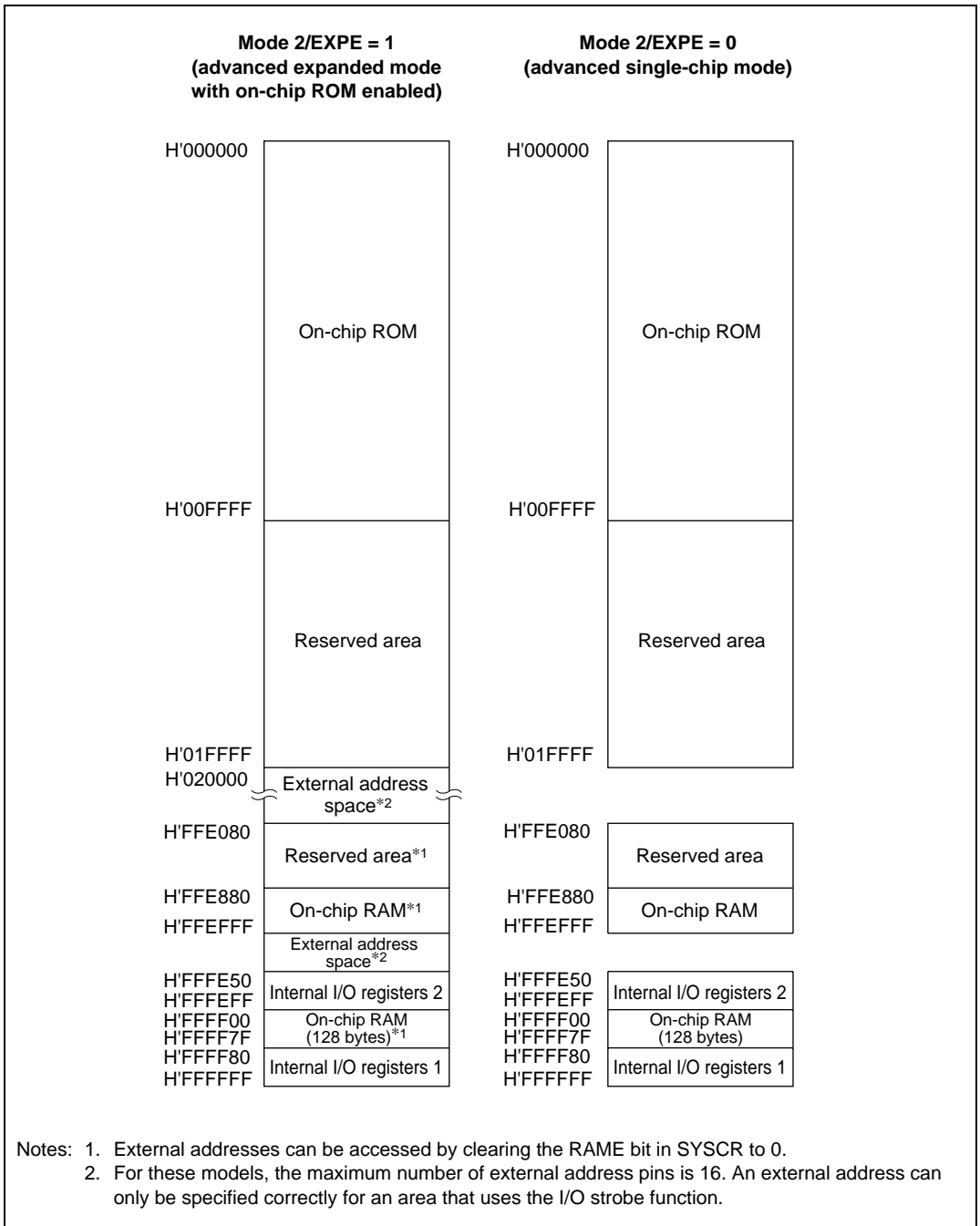


Figure 3.4 H8S/2137 and H8S/2132 Memory Map in Each Operating Mode (cont)

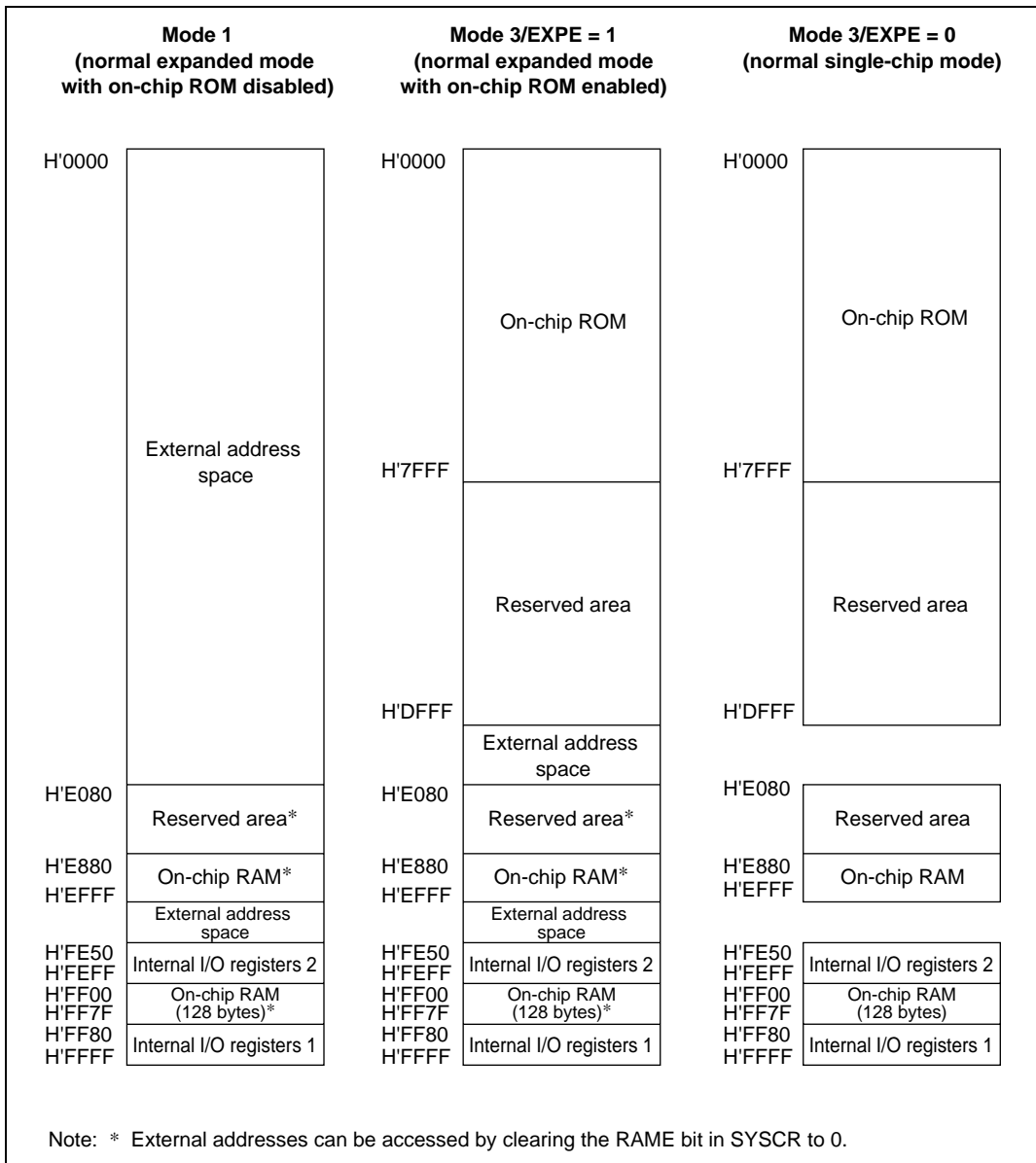


Figure 3.5 H8S/2130 Memory Map in Each Operating Mode

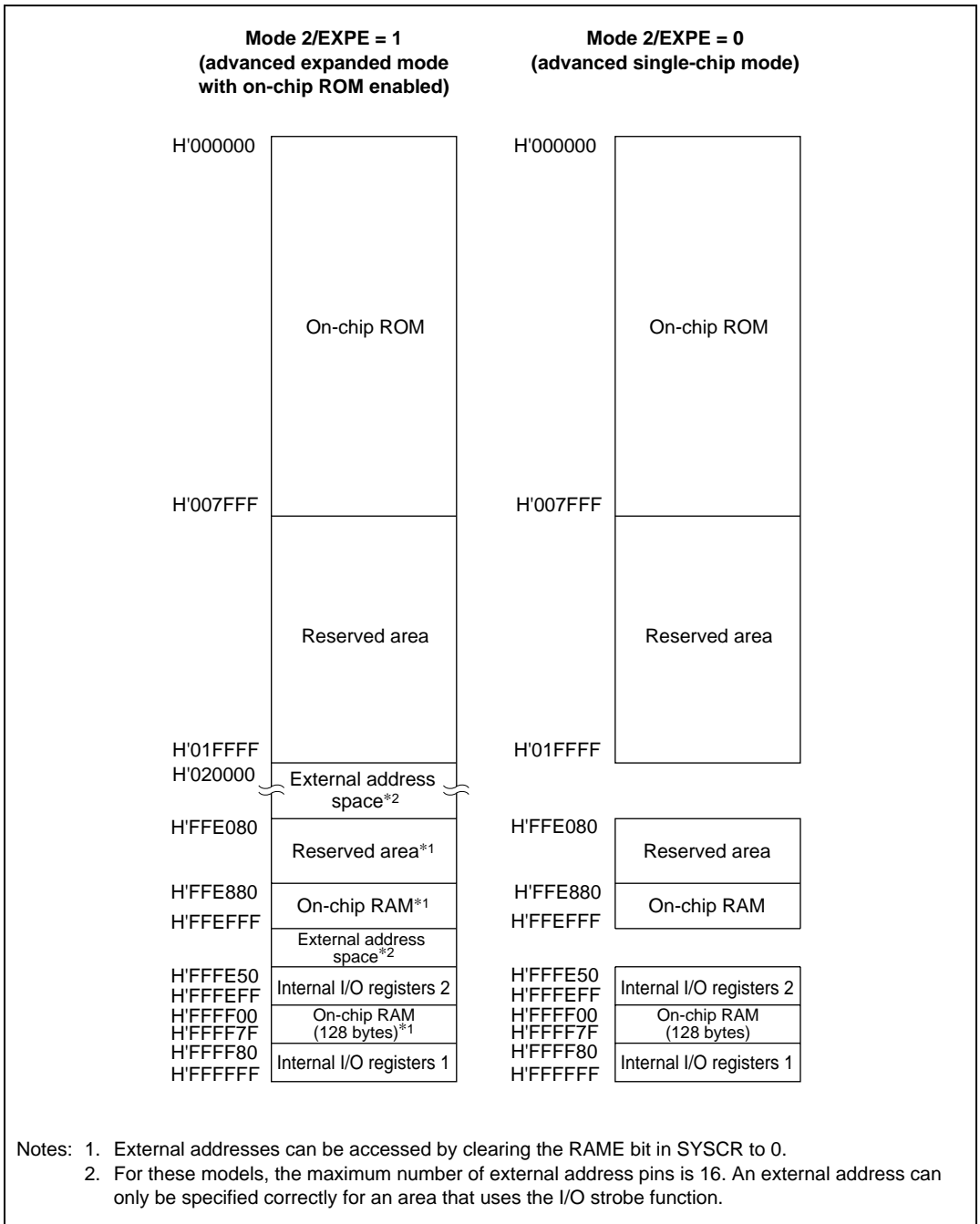


Figure 3.5 H8S/2130 Memory Map in Each Operating Mode (cont)

Section 4 Exception Handling

4.1 Overview

4.1.1 Exception Handling Types and Priority

As table 4.1 indicates, exception handling may be caused by a reset, direct transition, trap instruction, or interrupt. Exception handling is prioritized as shown in table 4.1. If two or more exceptions occur simultaneously, they are accepted and processed in order of priority. Trap instruction exceptions are accepted at all times in the program execution state.

Exception handling sources, the stack structure, and the operation of the CPU vary depending on the interrupt control mode set by the INTM0 and INTM1 bits in SYSCR.

Table 4.1 Exception Types and Priority

| Priority | Exception Type | Start of Exception Handling |
|-----------|----------------------------|--|
| High ↑ | Reset | Starts immediately after a low-to-high transition at the $\overline{\text{RES}}$ pin, or when the watchdog timer overflows. |
| | Trace | Starts when execution of the current instruction or exception handling ends, if the trace (T) bit is set to 1. (Cannot be used with this LSI.) |
| | Interrupt | Starts when execution of the current instruction or exception handling ends, if an interrupt request has been issued.*1 |
| | Direct transition | Started by a direct transition resulting from execution of a SLEEP instruction. |
| Low | Trap instruction (TRAPA)*2 | Started by execution of a trap instruction (TRAPA). |

- Notes: 1. Interrupt detection is not performed on completion of ANDC, ORC, XORC, or LDC instruction execution, or on completion of reset exception handling.
2. Trap instruction exception handling requests are accepted at all times in the program execution state.

4.1.2 Exception Handling Operation

Exceptions originate from various sources. Trap instructions and interrupts are handled as follows:

1. The program counter (PC) and condition-code register (CCR) are pushed onto the stack.
2. The interrupt mask bits are updated. The T bit is cleared to 0.
3. A vector address corresponding to the exception source is generated, and program execution starts from that address.

For a reset exception, steps 2 and 3 above are carried out.

4.1.3 Exception Sources and Vector Table

The exception sources are classified as shown in figure 4.1. Different vector addresses are assigned to different exception sources.

Table 4.2 lists the exception sources and their vector addresses.

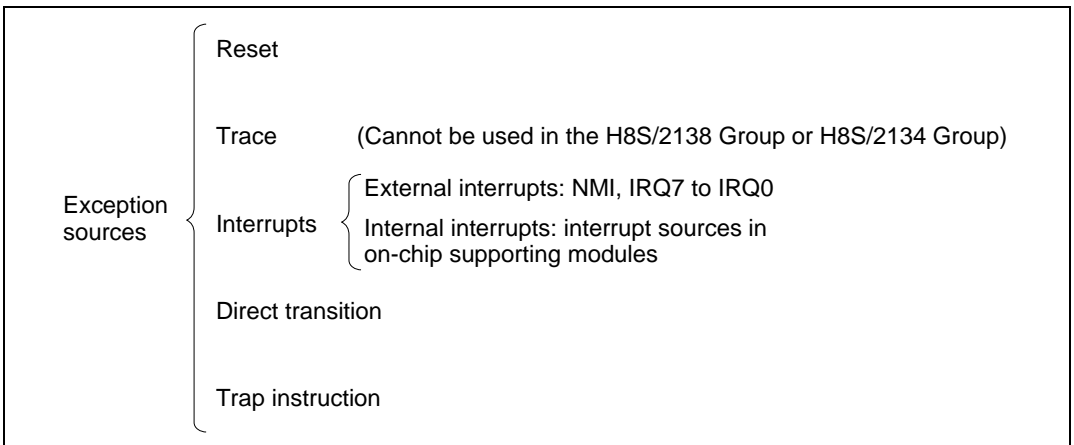


Figure 4.1 Exception Sources

Table 4.2 Exception Vector Table

| Exception Source | Vector Number | Vector Address*1 | | |
|------------------------------|---------------|------------------|------------------|------------------|
| | | Normal Mode | Advanced Mode | |
| Reset | 0 | H'0000 to H'0001 | H'0000 to H'0003 | |
| Reserved for system use | 1 | H'0002 to H'0003 | H'0004 to H'0007 | |
| | 2 | H'0004 to H'0005 | H'0008 to H'000B | |
| | 3 | H'0006 to H'0007 | H'000C to H'000F | |
| | 4 | H'0008 to H'0009 | H'0010 to H'0013 | |
| | 5 | H'000A to H'000B | H'0014 to H'0017 | |
| Direct transition | 6 | H'000C to H'000D | H'0018 to H'001B | |
| External interrupt NMI | 7 | H'000E to H'000F | H'001C to H'001F | |
| Trap instruction (4 sources) | 8 | H'0010 to H'0011 | H'0020 to H'0023 | |
| | 9 | H'0012 to H'0013 | H'0024 to H'0027 | |
| | 10 | H'0014 to H'0015 | H'0028 to H'002B | |
| | 11 | H'0016 to H'0017 | H'002C to H'002F | |
| Reserved for system use | 12 | H'0018 to H'0019 | H'0030 to H'0033 | |
| | 13 | H'001A to H'001B | H'0034 to H'0037 | |
| | 14 | H'001C to H'001D | H'0038 to H'003B | |
| | 15 | H'001E to H'001F | H'003C to H'003F | |
| External interrupt | IRQ0 | 16 | H'0020 to H'0021 | H'0040 to H'0043 |
| | IRQ1 | 17 | H'0022 to H'0023 | H'0044 to H'0047 |
| | IRQ2 | 18 | H'0024 to H'0025 | H'0048 to H'004B |
| | IRQ3 | 19 | H'0026 to H'0027 | H'004C to H'004F |
| | IRQ4 | 20 | H'0028 to H'0029 | H'0050 to H'0053 |
| | IRQ5 | 21 | H'002A to H'002B | H'0054 to H'0057 |
| | IRQ6 | 22 | H'002C to H'002D | H'0058 to H'005B |
| | IRQ7 | 23 | H'002E to H'002F | H'005C to H'005F |
| Internal interrupt*2 | 24 | H'0030 to H'0031 | H'0060 to H'0063 | |
| | 103 | H'00CE to H'00CF | H'019C to H'019F | |

Notes: 1. Lower 16 bits of the address.

2. For details on internal interrupt vectors, see section 5.3.3, Interrupt Exception Vector Table.

4.2 Reset

4.2.1 Overview

A reset has the highest exception priority.

When the $\overline{\text{RES}}$ pin goes low, all processing halts and the MCU enters the reset state. A reset initializes the internal state of the CPU and the registers of on-chip supporting modules. Immediately after a reset, interrupt control mode 0 is set.

Reset exception handling begins when the $\overline{\text{RES}}$ pin changes from low to high.

H8S/2138 Group and H8S/2134 Group MCUs can also be reset by overflow of the watchdog timer. For details, see section 14, Watchdog Timer (WDT).

4.2.2 Reset Sequence

The MCU enters the reset state when the $\overline{\text{RES}}$ pin goes low.

To ensure that the chip is reset, hold the $\overline{\text{RES}}$ pin low for at least 20 ms when powering on. To reset the chip during operation, hold the $\overline{\text{RES}}$ pin low for at least 20 states. For pin states in a reset, see appendix D.1, Port States in Each Processing State.

When the $\overline{\text{RES}}$ pin goes high after being held low for the necessary time, the chip starts reset exception handling as follows:

- [1] The internal state of the CPU and the registers of the on-chip supporting modules are initialized, and the I bit is set to 1 in CCR.
- [2] The reset exception vector address is read and transferred to the PC, and program execution starts from the address indicated by the PC.

Figures 4.2 and 4.3 show examples of the reset sequence.

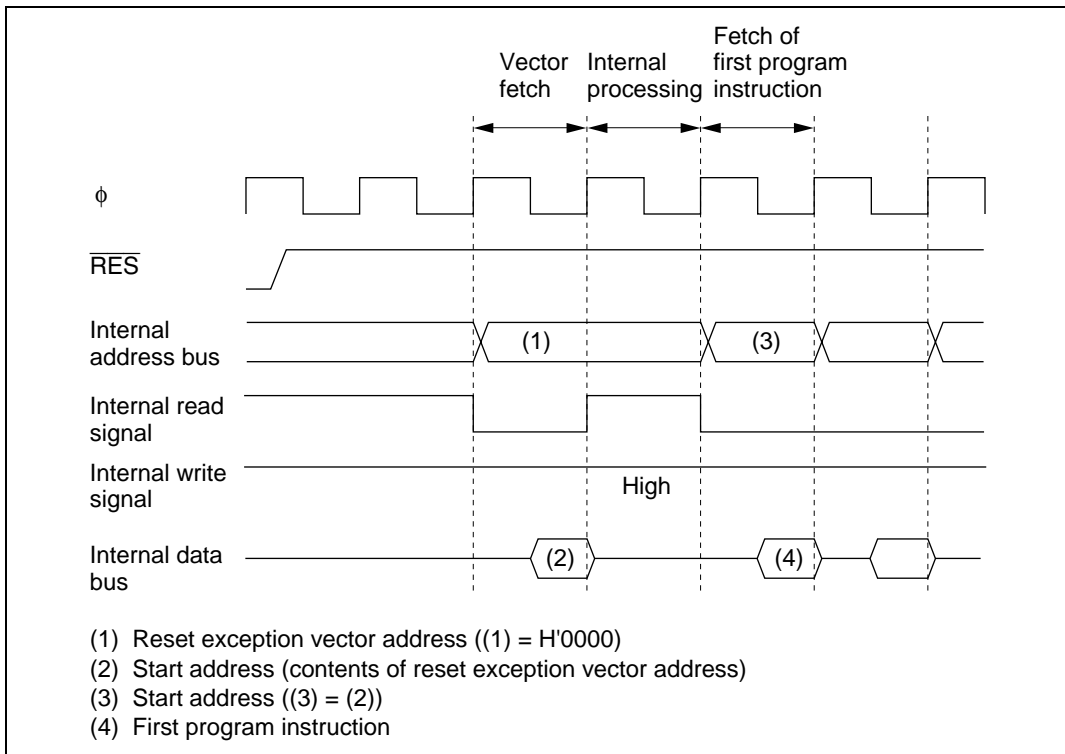


Figure 4.2 Reset Sequence (Mode 3)

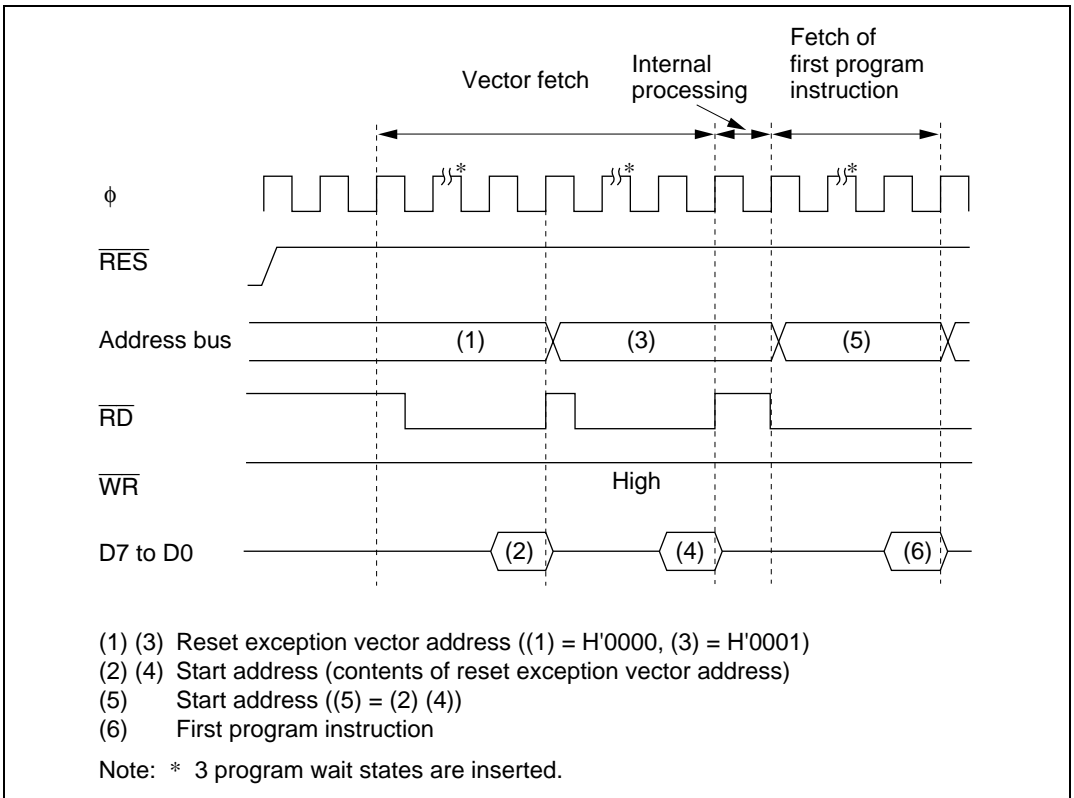


Figure 4.3 Reset Sequence (Mode 1)

4.2.3 Interrupts after Reset

If an interrupt is accepted after a reset but before the stack pointer (SP) is initialized, the PC and CCR will not be saved correctly, leading to a program crash. To prevent this, all interrupt requests, including NMI, are disabled immediately after a reset. Since the first instruction of a program is always executed immediately after the reset state ends, make sure that this instruction initializes the stack pointer (example: `MOV.L #xx:32, SP`).

4.3 Interrupts

Interrupt exception handling can be requested by nine external sources (NMI and IRQ7 to IRQ0) from 17 input pins (NMI, $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$, and $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$), and internal sources in the on-chip supporting modules. Figure 4.4 shows the interrupt sources and the number of interrupts of each type.

The on-chip supporting modules that can request interrupts include the watchdog timer (WDT), 16-bit free-running timer (FRT), 8-bit timer (TMR), serial communication interface (SCI), data transfer controller (DTC) (only in the H8S/2138 Group), A/D converter (ADC), host interface (HIF) (only in the H8S/2138 Group), and I²C bus interface (option). Each interrupt source has a separate vector address.

NMI is the highest-priority interrupt. Interrupts are controlled by the interrupt controller. The interrupt controller has two interrupt control modes and can assign interrupts other than NMI and address break to either three priority/mask levels to enable multiplexed interrupt control.

For details on interrupts, see section 5, Interrupt Controller.

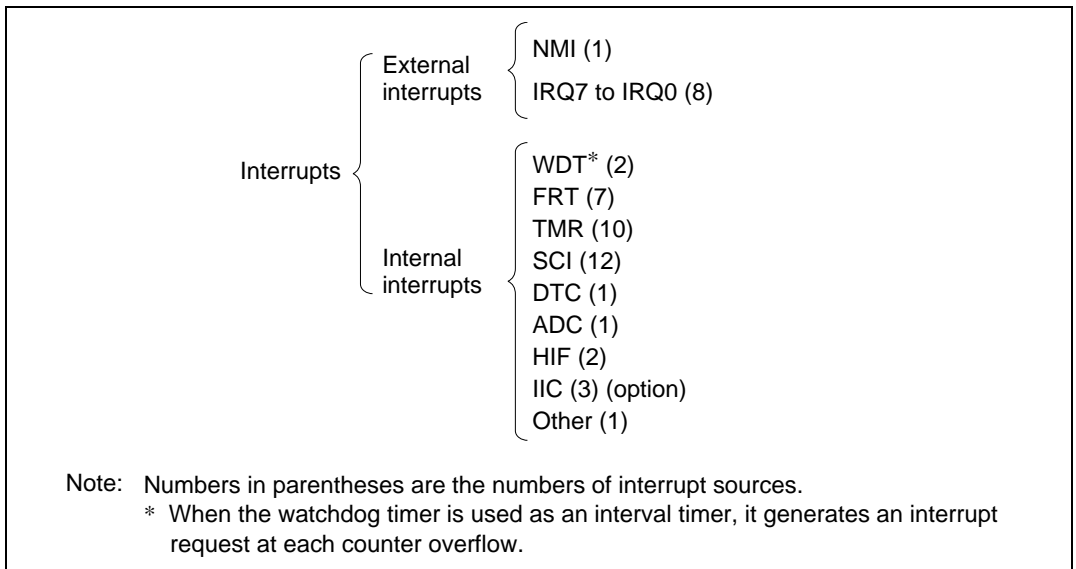


Figure 4.4 Interrupt Sources and Number of Interrupts

4.4 Trap Instruction

Trap instruction exception handling starts when a TRAPA instruction is executed. Trap instruction exception handling can be executed at all times in the program execution state.

The TRAPA instruction fetches a start address from a vector table entry corresponding to a vector number from 0 to 3, as specified in the instruction code.

Table 4.3 shows the status of CCR and EXR after execution of trap instruction exception handling.

Table 4.3 Status of CCR and EXR after Trap Instruction Exception Handling

| Interrupt Control Mode | CCR | | EXR | |
|------------------------|-----|----|----------|---|
| | I | UI | I2 to I0 | T |
| 0 | 1 | — | — | — |
| 1 | 1 | 1 | — | — |

Legend:

1: Set to 1

0: Cleared to 0

—: Retains value prior to execution.

4.5 Stack Status after Exception Handling

Figure 4.5 shows the stack after completion of trap instruction exception handling and interrupt exception handling.

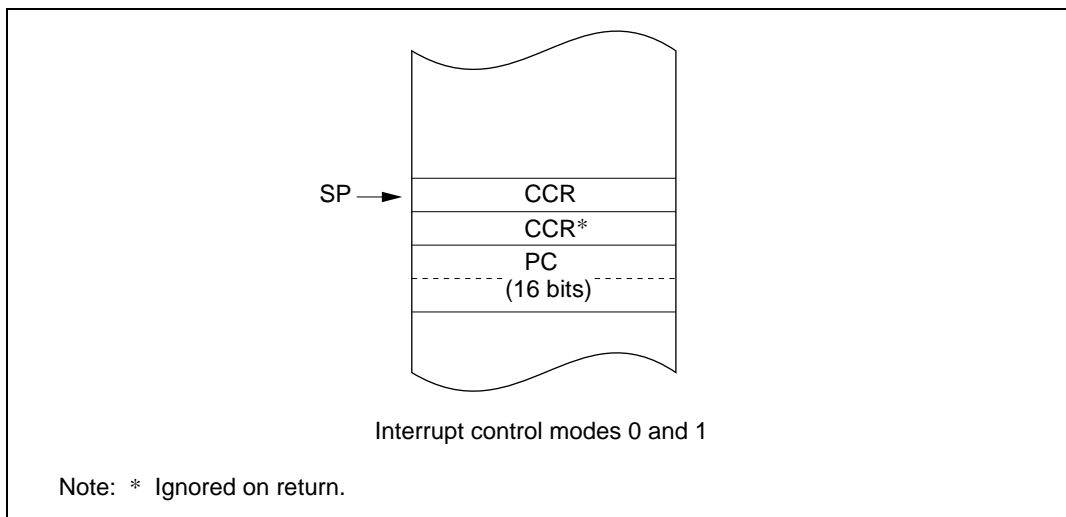


Figure 4.5 (1) Stack Status after Exception Handling (Normal Mode)

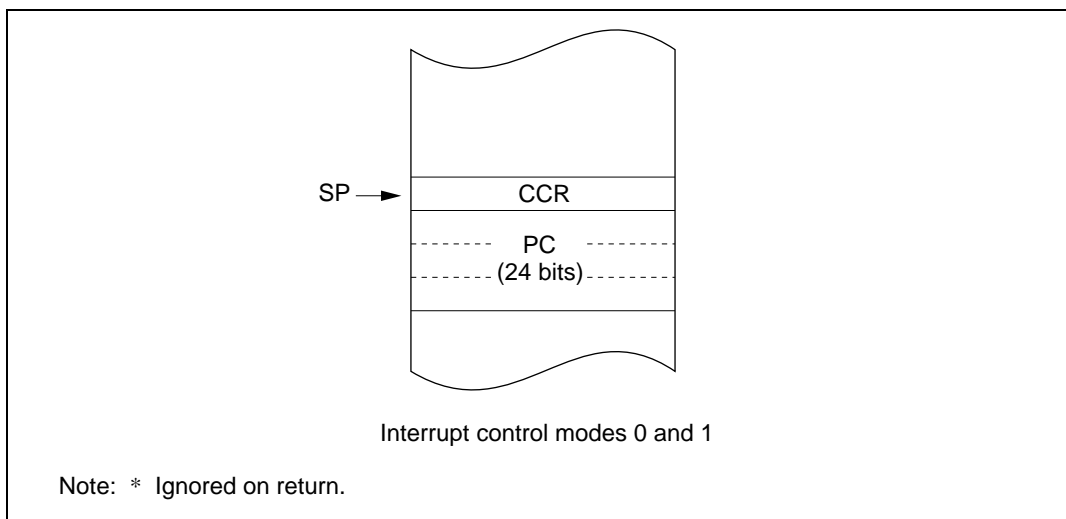


Figure 4.5 (2) Stack Status after Exception Handling (Advanced Mode)

4.6 Notes on Use of the Stack

When accessing word data or longword data, the H8S/2138 Group or H8S/2134 Group chip assumes that the lowest address bit is 0. The stack should always be accessed by word transfer instruction or longword transfer instruction, and the value of the stack pointer (SP: ER7) should always be kept even. Use the following instructions to save registers:

```
PUSH.W   Rn      (or MOV.W Rn, @-SP)
PUSH.L   ERn     (or MOV.L ERn, @-SP)
```

Use the following instructions to restore registers:

```
POP.W    Rn      (or MOV.W @SP+, Rn)
POP.L    ERn     (or MOV.L @SP+, ERn)
```

Setting SP to an odd value may lead to a malfunction. Figure 4.6 shows an example of what happens when the SP value is odd.

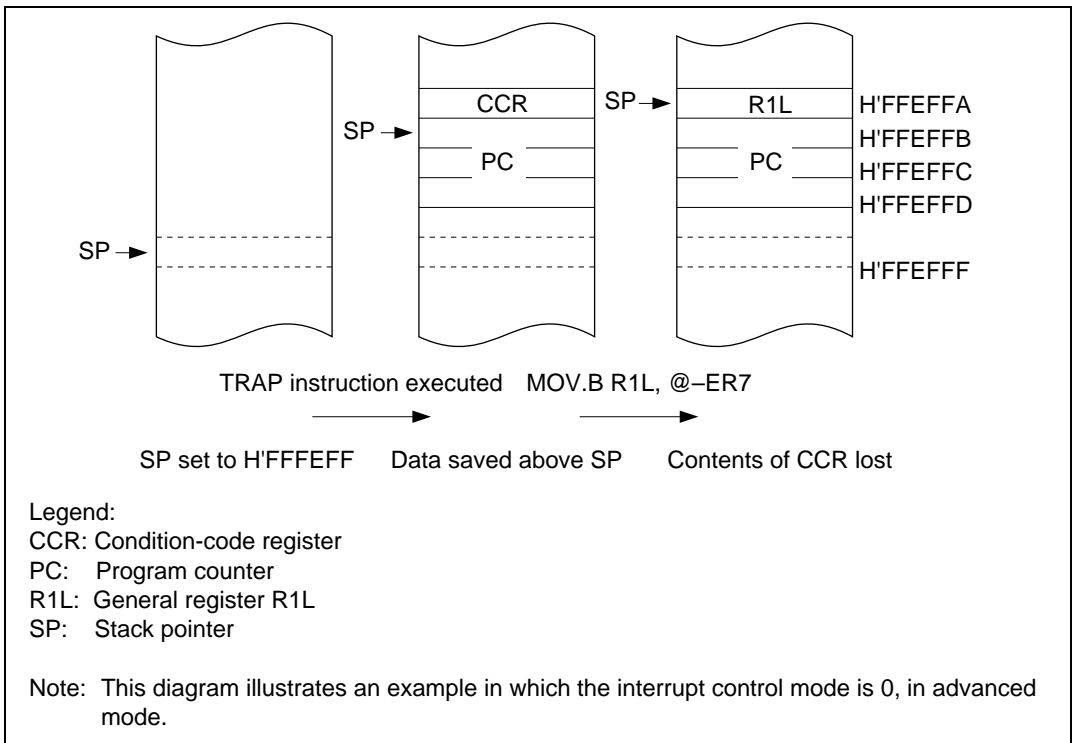


Figure 4.6 Operation When SP Value Is Odd

Section 5 Interrupt Controller

5.1 Overview

5.1.1 Features

H8S/2138 Group and H8S/2134 Group MCUs control interrupts by means of an interrupt controller. The interrupt controller has the following features:

- Two interrupt control modes
 - Either of two interrupt control modes can be set by means of the INTM1 and INTM0 bits in the system control register (SYSCR).
- Priorities settable with ICR
 - An interrupt control register (ICR) is provided for setting interrupt priorities. Three priority levels can be set for each module for all interrupts except NMI and address break.
- Independent vector addresses
 - All interrupt sources are assigned independent vector addresses, making it unnecessary for the source to be identified in the interrupt handling routine.
- Fifteen external interrupt pins (nine external sources)
 - NMI is the highest-priority interrupt, and is accepted at all times. A rising or falling edge at the NMI pin can be selected for the NMI interrupt.
 - Falling edge, rising edge, or both edge detection, or level sensing, at pins $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ can be selected for interrupts IRQ7 to IRQ0.
 - The IRQ6 interrupt is shared by the interrupt from the $\overline{\text{IRQ6}}$ pin and eight external interrupt inputs ($\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$).
- DTC control
 - DTC activation is controlled by means of interrupts.

5.1.2 Block Diagram

A block diagram of the interrupt controller is shown in figure 5.1.

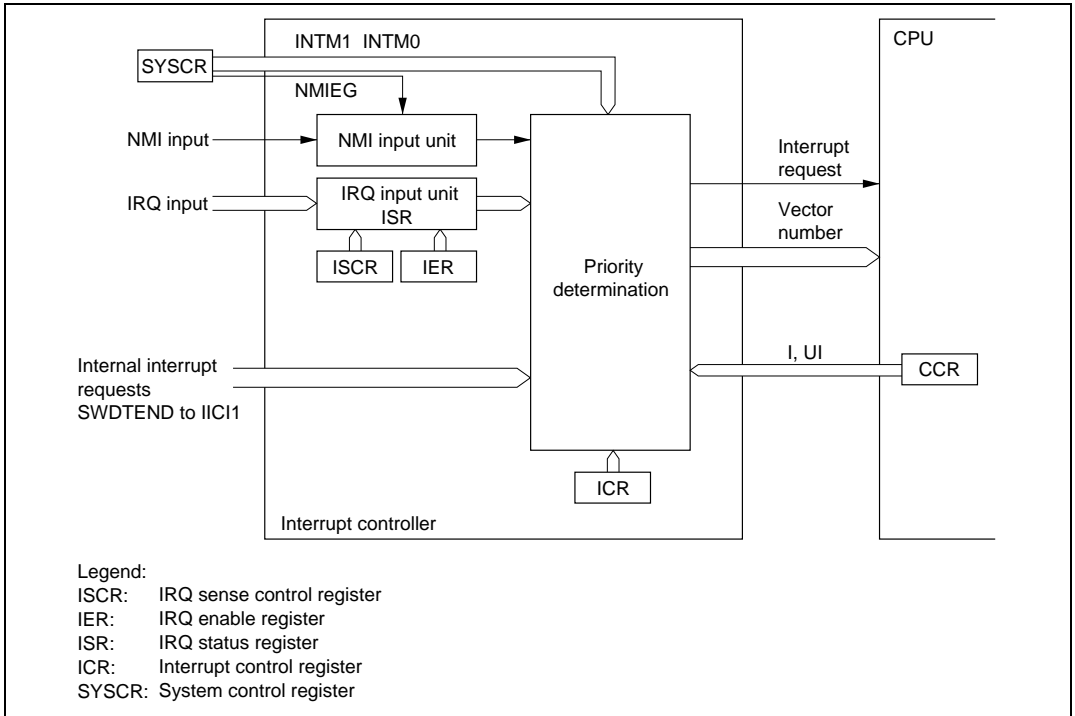


Figure 5.1 Block Diagram of Interrupt Controller

5.1.3 Pin Configuration

Table 5.1 summarizes the pins of the interrupt controller.

Table 5.1 Interrupt Controller Pins

| Name | Symbol | I/O | Function |
|-------------------------------------|--|-------|--|
| Nonmaskable interrupt | NMI | Input | Nonmaskable external interrupt; rising or falling edge can be selected |
| External interrupt requests 7 to 0 | $\overline{\text{IRQ}}7$ to $\overline{\text{IRQ}}0$ | Input | Maskable external interrupts; rising, falling, or both edges, or level sensing, can be selected. |
| Key input interrupt requests 7 to 0 | $\overline{\text{KIN}}7$ to $\overline{\text{KIN}}0$ | Input | Maskable external interrupts: falling edge or level sensing can be selected. |

5.1.4 Register Configuration

Table 5.2 summarizes the registers of the interrupt controller.

Table 5.2 Interrupt Controller Registers

| Name | Abbreviation | R/W | Initial Value | Address* ¹ |
|---|--------------|---------------------|---------------|-----------------------|
| System control register | SYSCR | R/W | H'09 | H'FFC4 |
| IRQ sense control register H | ISCRH | R/W | H'00 | H'FEEC |
| IRQ sense control register L | ISCR L | R/W | H'00 | H'FEED |
| IRQ enable register | IER | R/W | H'00 | H'FFC2 |
| IRQ status register | ISR | R/(W)* ² | H'00 | H'FEEB |
| Keyboard matrix interrupt mask register | KMIMR | R/W | H'BF | H'FFF1* ³ |
| Interrupt control register A | ICRA | R/W | H'00 | H'FEE8 |
| Interrupt control register B | ICRB | R/W | H'00 | H'FEE9 |
| Interrupt control register C | ICRC | R/W | H'00 | H'FEEA |
| Address break control register | ABRKCR | R/W | H'00 | H'FEF4 |
| Break address register A | BARA | R/W | H'00 | H'FEF5 |
| Break address register B | BARB | R/W | H'00 | H'FEF6 |
| Break address register C | BARC | R/W | H'00 | H'FEF7 |

Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written, for flag clearing.

3. When setting KMIMR, the HIE bit in SYSCR must be set to 1, and also MSTP2 bit in MSTPCRL must be set to 0.

5.2 Register Descriptions

5.2.1 System Control Register (SYSCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|------|-------|-----|------|
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

SYSCR is an 8-bit readable/writable register of which bits 5, 4, and 2 select the interrupt control mode and the detected edge for NMI.

Only bits 5, 4, and 2 are described here; for details on the other bits, see section 3.2.2, System Control Register (SYSCR).

SYSCR is initialized to H'09 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 5 and 4—Interrupt Control Mode 1 and 0 (INTM1, INTM0): These bits select one of four interrupt control modes for the interrupt controller. The INTM1 bit must not be set to 1.

| Bit 5 | Bit 4 | Interrupt Control Mode | Description |
|-------|-------|------------------------|--|
| INTM1 | INTM0 | | |
| 0 | 0 | 0 | Interrupts are controlled by I bit (Initial value) |
| | 1 | 1 | Interrupts are controlled by I and UI bits and ICR |
| 1 | 0 | 2 | Cannot be used in the H8S/2138 Group or H8S/2134 Group |
| | 1 | 3 | Cannot be used in the H8S/2138 Group or H8S/2134 Group |

Bit 2—NMI Edge Select (NMIEG): Selects the input edge for the NMI pin.

| Bit 2 | Description |
|-------|--|
| NMIEG | |
| 0 | Interrupt request generated at falling edge of NMI input (Initial value) |
| 1 | Interrupt request generated at rising edge of NMI input |

5.2.2 Interrupt Control Registers A to C (ICRA to ICRC)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

The ICR registers are three 8-bit readable/writable registers that set the interrupt control level for interrupts other than NMI and address break.

The correspondence between ICR settings and interrupt sources is shown in table 5.3.

The ICR registers are initialized to H'00 by a reset and in hardware standby mode.

Bit n—Interrupt Control Level (ICRn): Sets the control level for the corresponding interrupt source.

Bit n

| ICRn | Description |
|------|--|
| 0 | Corresponding interrupt source is control level 0 (non-priority) (Initial value) |
| 1 | Corresponding interrupt source is control level 1 (priority) |

(n = 7 to 0)

Table 5.3 Correspondence between Interrupt Sources and ICR Settings

| Register | Bits | | | | | | | |
|----------|------------------|---------------------------|------------------|------------------------------|------------------------------|-----------------------------|------------------------------------|---------------------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| ICRA | IRQ0 | IRQ1 | IRQ2 IRQ3 | IRQ4 IRQ5 | IRQ6 IRQ7 | DTC | Watchdog timer 0 | Watchdog timer 1 |
| ICRB | A/D converter | Free- running timer | — | — | 8-bit timer channel 0 | 8-bit timer channel 1 | 8-bit timer channels X, Y | HIF |
| ICRC | SCI channel 0 | SCI channel 1 | SCI channel 2 | IIC channel 0 (option) | IIC channel 1 (option) | — | — | — |

5.2.3 IRQ Enable Register (IER)

| | | | | | | | | |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IRQ7E | IRQ6E | IRQ5E | IRQ4E | IRQ3E | IRQ2E | IRQ1E | IRQ0E |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

IER is an 8-bit readable/writable register that controls enabling and disabling of interrupt requests IRQ7 to IRQ0.

IER is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 0—IRQ7 to IRQ0 Enable (IRQ7E to IRQ0E): These bits select whether IRQ7 to IRQ0 are enabled or disabled.

Bit n

| IRQnE | Description |
|-------|---|
| 0 | IRQn interrupt disabled (Initial value) |
| 1 | IRQn interrupt enabled |

(n = 7 to 0)

5.2.4 IRQ Sense Control Registers H and L (ISCRH, ISCRL)

- ISCRH

| | | | | | | | | |
|---------------|---------|---------|---------|---------|---------|---------|---------|---------|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | IRQ7SCB | IRQ7SCA | IRQ6SCB | IRQ6SCA | IRQ5SCB | IRQ5SCA | IRQ4SCB | IRQ4SCA |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

- ISCRL

| | | | | | | | | |
|---------------|---------|---------|---------|---------|---------|---------|---------|---------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IRQ3SCB | IRQ3SCA | IRQ2SCB | IRQ2SCA | IRQ1SCB | IRQ1SCA | IRQ0SCB | IRQ0SCA |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

ISCRH and ISCR L are 8-bit readable/writable registers that select rising edge, falling edge, or both edge detection, or level sensing, for the input at pins $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$.

Each of the ISCR registers is initialized to H'00 by a reset and in hardware standby mode.

ISCRH Bits 7 to 0, ISCR L Bits 7 to 0: IRQ7 Sense Control A and B (IRQ7SCA, IRQ7SCB) to IRQ0 Sense Control A and B (IRQ0SCA, IRQ0SCB)

| ISCRH Bits 7 to 0 ISCR L Bits 7 to 0 | | |
|---|-----------------------|--|
| IRQ7SCB to IRQ0SCB | IRQ7SCA to IRQ0SCA | Description |
| 0 | 0 | Interrupt request generated at $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input low level (Initial value) |
| | 1 | Interrupt request generated at falling edge of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input |
| 1 | 0 | Interrupt request generated at rising edge of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input |
| | 1 | Interrupt request generated at both falling and rising edges of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input |

5.2.5 IRQ Status Register (ISR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | IRQ7F | IRQ6F | IRQ5F | IRQ4F | IRQ3F | IRQ2F | IRQ1F | IRQ0F |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* |

Note: * Only 0 can be written, to clear the flag.

ISR is an 8-bit readable/writable register that indicates the status of IRQ7 to IRQ0 interrupt requests.

ISR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 0—IRQ7 to IRQ0 Flags (IRQ7F to IRQ0F): These bits indicate the status of IRQ7 to IRQ0 interrupt requests.

Bit n

| IRQnF | Description |
|-------|--|
| 0 | <p>[Clearing conditions] (Initial value)</p> <ul style="list-style-type: none"> • Cleared by reading IRQnF when set to 1, then writing 0 in IRQnF • When interrupt exception handling is executed when low-level detection is set (IRQnSCB = IRQnSCA = 0) and $\overline{\text{IRQn}}$ input is high* • When IRQn interrupt exception handling is executed when falling, rising, or both-edge detection is set (IRQnSCB = 1 or IRQnSCA = 1)* |
| 1 | <p>[Setting conditions]</p> <ul style="list-style-type: none"> • When $\overline{\text{IRQn}}$ input goes low when low-level detection is set (IRQnSCB = IRQnSCA = 0) • When a falling edge occurs in $\overline{\text{IRQn}}$ input when falling edge detection is set (IRQnSCB = 0, IRQnSCA = 1) • When a rising edge occurs in $\overline{\text{IRQn}}$ input when rising edge detection is set (IRQnSCB = 1, IRQnSCA = 0) • When a falling or rising edge occurs in $\overline{\text{IRQn}}$ input when both-edge detection is set (IRQnSCB = IRQnSCA = 1) |

(n = 7 to 0)

Note: * When a product, in which a DTC is incorporated, is used in the following settings, the corresponding flag bit is not automatically cleared even when exception handling, which is a clear condition, is executed and the bit is held at 1.

- (1) When DTCEA3 is set to 1 (ADI is set to an interrupt source), IRQ4F flag is not automatically cleared.
- (2) When DTCEA2 is set to 1 (ICIA is set to an interrupt source), IRQ5F flag is not automatically cleared.
- (3) When DTCEA1 is set to 1 (ICIB is set to an interrupt source), IRQ6F flag is not automatically cleared.
- (4) When DTCEA0 is set to 1 (OCIA is set to an interrupt source), IRQ7F flag is not automatically cleared.

When activation interrupt sources of DTC and IRQ interrupts are used with the above combinations, clear the interrupt flag by software in the interrupt handling routine of the corresponding IRQ.

5.2.6 Keyboard Matrix Interrupt Mask Register (KMIMR)

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | KMIMR7 | KMIMR6 | KMIMR5 | KMIMR4 | KMIMR3 | KMIMR2 | KMIMR1 | KMIMR0 |
| Initial value | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

KMIMR is an 8-bit readable/writable register that performs mask control for the keyboard matrix interrupt inputs (pins $\overline{KIN7}$ to $\overline{KIN0}$) and $\overline{IRQ6}$ pin. To enable key-sense input interrupts from multiple pin inputs in keyboard matrix scanning/sensing, clear the corresponding mask bits to 0.

KMIMR is initialized to H'BF by a reset and in hardware standby mode, and only $\overline{IRQ6}$ ($\overline{KIN6}$) input is enabled.

Bits 7 to 0—Keyboard Matrix Interrupt Mask (KMIMR7 to KMIMR0): These bits control key-sense input interrupt requests (KIN7 to KIN0).

Bits 7 to 0

KMIMR7 to KMIMR0

| | Description | |
|---|---|------------------|
| 0 | Key-sense input interrupt requests enabled | |
| 1 | Key-sense input interrupt requests disabled | (Initial value)* |

Note: * However, the initial value of KMIMR6 is 0 because the KMIMR6 bit controls both $\overline{IRQ6}$ interrupt request masking and key-sense input enabling.

Figure 5.2 shows the relationship between interrupts $\overline{IRQ6}$, interrupts $\overline{KIN7}$ to $\overline{KIN0}$, and registers KMIMR.

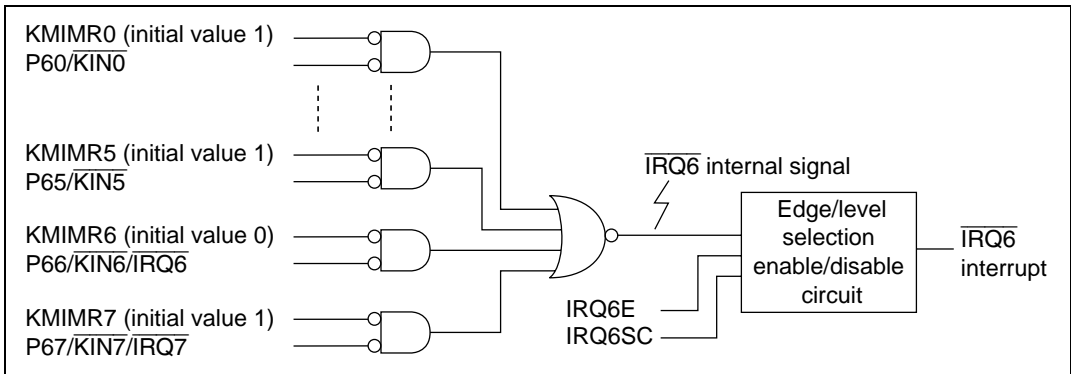


Figure 5.2 Relationship between Interrupts IRQ6, Interrupts KIN7 to KIN0, and Registers KMIMR

When pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$ are used as key-sense interrupt input pins, either low-level sensing or falling-edge sensing must be designated as the interrupt sense condition for the corresponding interrupt source (IRQ6).

5.2.7 Address Break Control Register (ABRKCR)

| | | | | | | | | |
|---------------|-----|---|---|---|---|---|---|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | CMF | — | — | — | — | — | — | BIE |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | — | — | — | — | — | — | R/W |

ABRKCR is an 8-bit readable/writable register that performs address break control.

ABRKCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Condition Match Flag (CMF): This is the address break source flag, used to indicate that the address set by BAR has been prefetched. When the CMF flag and BIE flag are both set to 1, an address break is requested.

Bit 7

| CMF | Description |
|-----|---|
| 0 | [Clearing condition] When address break interrupt exception handling is executed (Initial value) |
| 1 | [Setting condition] When address set by BARA to BARC is prefetched while BIE = 1 |

Bits 6 to 1—Reserved: These bits cannot be modified and are always read as 0.

Bit 0—Break Interrupt Enable (BIE): Selects address break enabling or disabling.

Bit 0

| BIE | Description |
|-----|--|
| 0 | Address break disabled (Initial value) |
| 1 | Address break enabled |

5.2.8 Break Address Registers A, B, C (BARA, BARB, BARC)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| BARA | A23 | A22 | A21 | A20 | A19 | A18 | A17 | A16 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| BARB | A15 | A14 | A13 | A12 | A11 | A10 | A9 | A8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|---|
| BARC | A7 | A6 | A5 | A4 | A3 | A2 | A1 | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | — |

BAR consists of three 8-bit readable/writable registers (BARA, BARB, and BARC), and is used to specify the address at which an address break is to be executed.

Each of the BAR registers is initialized to H'00 by a reset and in hardware standby mode. They are not initialized in software standby mode.

BARA Bits 7 to 0—Address 23 to 16 (A23 to A16)

BARB Bits 7 to 0—Address 15 to 8 (A15 to A8)

BARC Bits 7 to 1—Address 7 to 1 (A7 to A1)

These bits specify the address at which an address break is to be executed. BAR bits A15 to A1 are compared with internal address bus lines A15 to A1, respectively.

The address at which the first instruction byte is located should be specified as the break address. Occurrence of the address break condition may not be recognized for other addresses.

In normal mode, no comparison is made with address lines A23 to A16.

BARC Bit 0—Reserved: This bit cannot be modified and is always read as 0.

5.3 Interrupt Sources

Interrupt sources comprise external interrupts (NMI and IRQ7 to IRQ0) and internal interrupts.

5.3.1 External Interrupts

There are nine external interrupt sources from 17 input pins (15 actual pins): NMI, $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$, and $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$. KIN7 to KIN0 share the IRQ6 interrupt source. Of these, NMI, IRQ7, IRQ6, and IRQ2 to IRQ0 can be used to restore the H8S/2138 Group or H8S/2134 Group chip from software standby mode.

NMI Interrupt: NMI is the highest-priority interrupt, and is always accepted by the CPU regardless of the interrupt control mode and the status of the CPU interrupt mask bits. The NMIEG bit in SYSCR can be used to select whether an interrupt is requested at a rising edge or a falling edge on the NMI pin.

The vector number for NMI interrupt exception handling is 7.

IRQ7 to IRQ0 Interrupts: Interrupts IRQ7 to IRQ0 are requested by an input signal at pins $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$. Interrupts IRQ7 to IRQ0 have the following features:

- Using ISCR, it is possible to select whether an interrupt is generated by a low level, falling edge, rising edge, or both edges, at pins $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$.
- Enabling or disabling of interrupt requests IRQ7 to IRQ0 can be selected with IER.
- The interrupt control level can be set with ICR.
- The status of interrupt requests IRQ7 to IRQ0 is indicated in ISR. ISR flags can be cleared to 0 by software.

A block diagram of interrupts IRQ7 to IRQ0 is shown in figure 5.3.

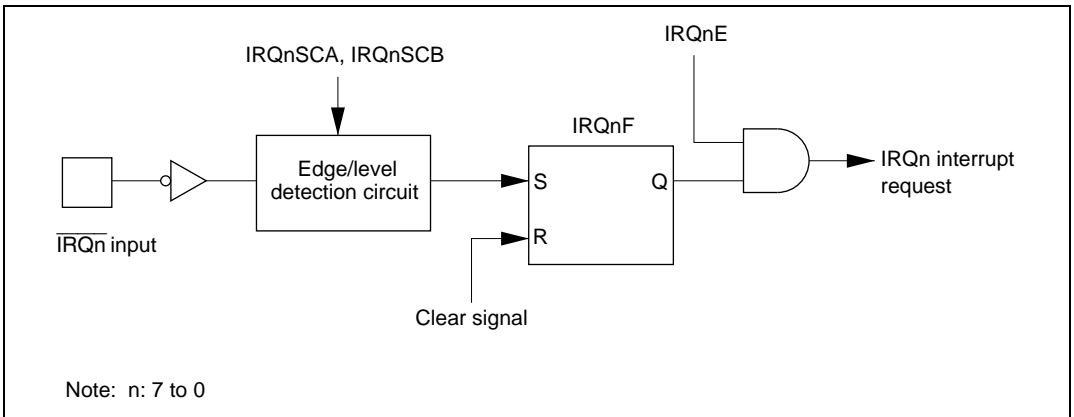


Figure 5.3 Block Diagram of Interrupts IRQ7 to IRQ0

Figure 5.4 shows the timing of IRQnF setting.

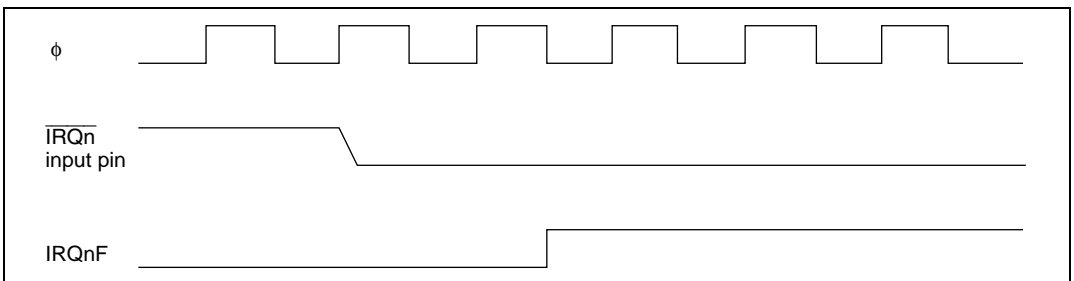


Figure 5.4 Timing of IRQnF Setting

The vector numbers for IRQ7 to IRQ0 interrupt exception handling are 23 to 16.

Detection of IRQ7 to IRQ0 interrupts does not depend on whether the relevant pin has been set for input or output. Therefore, when a pin is used as an external interrupt input pin, do not clear the corresponding DDR bit to 0 and use the pin as an I/O pin for another function. When the $\overline{\text{IRQ6}}$ pin is assigned as the IRQ6 interrupt input pin, then set the KMIMR6 bit to 0.

As interrupt request flags IRQ7F to IRQ0F are set when the setting condition is met, regardless of the IER setting, only the necessary flags should be referenced.

Interrupts KIN7 to KIN0: Interrupts KIN7 to KIN0 are requested by input signals at pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$. When any of pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$ are used as key-sense inputs, the corresponding KMIMR bits should be cleared to 0 to enable those key-sense input interrupts. The remaining unused key-sense input KMIMR bits should be set to 1 to disable those interrupts. Interrupts KIN7 to KIN0 correspond to the IRQ6 interrupt. Interrupt request generation pin conditions, interrupt request enabling, interrupt control level setting, and interrupt request status indications, are all in accordance with the IRQ6 interrupt settings.

When pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$ are used as key-sense interrupt input pins, either low-level sensing or falling-edge sensing must be designated as the interrupt sense condition for the corresponding interrupt source (IRQ6).

5.3.2 Internal Interrupts

There are 38 sources for internal interrupts from on-chip supporting modules, plus one software interrupt source (address break).

- For each on-chip supporting module there are flags that indicate the interrupt request status, and enable bits that select enabling or disabling of these interrupts. If any one of these is set to 1, an interrupt request is issued to the interrupt controller.
- The interrupt control level can be set by means of ICR.
- The DTC can be activated by an FRT, TMR, SCI, or other interrupt request. When the DTC is activated by an interrupt, the interrupt control mode and interrupt mask bits have no effect.

5.3.3 Interrupt Exception Vector Table

Table 5.4 shows interrupt exception handling sources, vector addresses, and interrupt priorities. For default priorities, the lower the vector number, the higher the priority.

Priorities among modules can be set by means of ICR. The situation when two or more modules are set to the same priority, and priorities within a module, are fixed as shown in table 5.4.

Table 5.4 Interrupt Sources, Vector Addresses, and Interrupt Priorities

| Interrupt Source | Origin of Interrupt Source | Vector Number | Vector Address | | ICR | Priority | | |
|---|----------------------------|---------------|------------------|----------------------|----------|----------------------|-------|-----|
| | | | Normal Mode | Advanced Mode | | | | |
| NMI | pin | 7 | H'000E | H'00001C | | High ↑ | | |
| IRQ0 | | 16 | H'0020 | H'000040 | ICRA7 | | | |
| IRQ1 | | 17 | H'0022 | H'000044 | ICRA6 | | | |
| IRQ2 | | 18 | H'0024 | H'000048 | ICRA5 | | | |
| IRQ3 | | 19 | H'0026 | H'00004C | | | | |
| IRQ4 | | 20 | H'0028 | H'000050 | ICRA4 | | | |
| IRQ5 | | 21 | H'002A | H'000054 | | | | |
| IRQ6, KIN7 to KIN0 | | 22 | H'002C | H'000058 | ICRA3 | | | |
| IRQ7 | | 23 | H'002E | H'00005C | | | | |
| SWDTEND (software activation interrupt end) | | DTC | 24 | H'0030 | H'000060 | | ICRA2 | |
| WOVI0 (interval timer) | Watchdog timer 0 | 25 | H'0032 | H'000064 | ICRA1 | | | |
| WOVI1 (interval timer) | Watchdog timer 1 | 26 | H'0034 | H'000068 | ICRA0 | | | |
| Address break (PC break) | — | 27 | H'0036 | H'00006C | | | | |
| ADI (A/D conversion end) | A/D | 28 | H'0038 | H'000070 | ICRB7 | | | |
| Reserved | — | 29 to 47 | H'003A to H'005E | H'000074 to H'0000BC | | | | |
| ICIA (input capture A) | Free-running timer | 48 | H'0060 | H'0000C0 | ICRB6 | | | |
| ICIB (input capture B) | | 49 | H'0062 | H'0000C4 | | | | |
| ICIC (input capture C) | | 50 | H'0064 | H'0000C8 | | | | |
| ICID (input capture D) | | 51 | H'0066 | H'0000CC | | | | |
| OCIA (output compare A) | | 52 | H'0068 | H'0000D0 | | | | |
| OCIB (output compare B) | | 53 | H'006A | H'0000D4 | | | | |
| FOVI (overflow) | | 54 | H'006C | H'0000D8 | | | | |
| Reserved | | 55 | H'006E | H'0000DC | | | | |
| Reserved | | — | 56 to 63 | H'0070 to H'007E | | H'0000E0 to H'0000FC | | Low |

5.4 Address Breaks

5.4.1 Features

With the H8S/2138 Group and H8S/2134 Group, it is possible to identify the prefetch of a specific address by the CPU and generate an address break interrupt, using the ABRKCR and BAR registers. When an address break interrupt is generated, address break interrupt exception handling is executed.

This function can be used to detect the beginning of execution of a bug location in the program, and branch to a correction routine.

5.4.2 Block Diagram

A block diagram of the address break function is shown in figure 5.5.

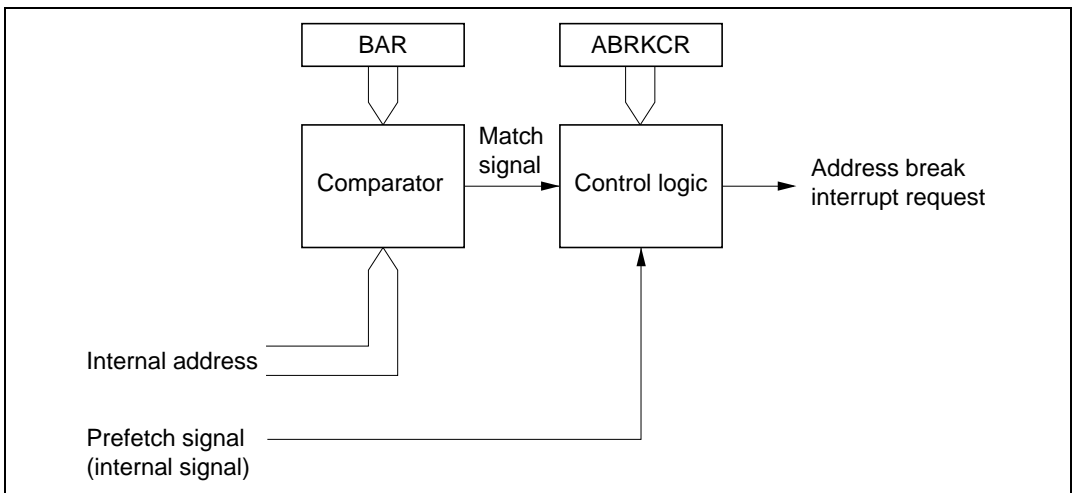


Figure 5.5 Block Diagram of Address Break Function

5.4.3 Operation

ABRKCR and BAR settings can be made so that an address break interrupt is generated when the CPU prefetches the address set in BAR. This address break function issues an interrupt request to the interrupt controller when the address is prefetched, and the interrupt controller determines the interrupt priority. When the interrupt is accepted, interrupt exception handling is started on completion of the currently executing instruction. With an address break interrupt, interrupt mask control by the I and UI bits in the CPU's CCR is ineffective.

The register settings when the address break function is used are as follows.

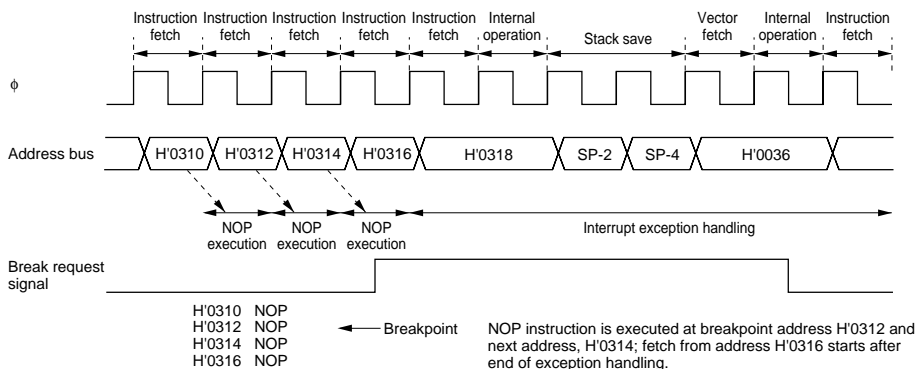
1. Set the break address in bits A23 to A1 in BAR.
2. Set the BIE bit in ABRKCR to 1 to enable address breaks. An address break will not be requested if the BIE bit is cleared to 0.

When the setting condition occurs, the CMF flag in ABRKCR is set to 1 and an interrupt is requested. If necessary, the source should be identified in the interrupt handling routine.

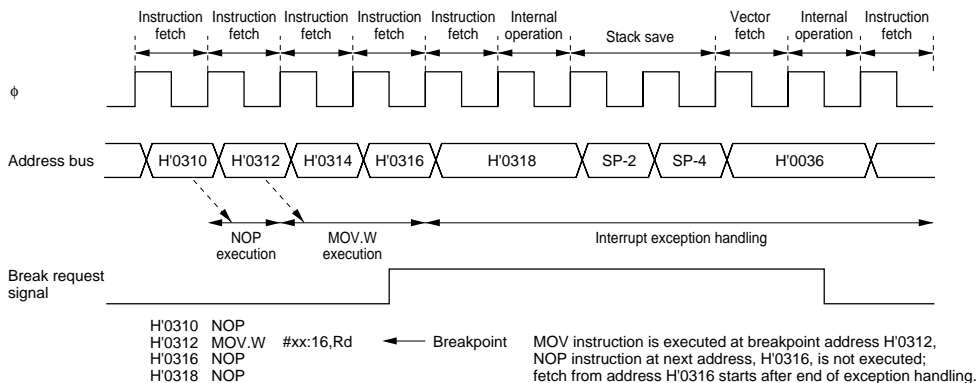
5.4.4 Usage Notes

1. With the address break function, the address at which the first instruction byte is located should be specified as the break address. Occurrence of the address break condition may not be recognized for other addresses.
2. In normal mode, no comparison is made with address lines A23 to A16.
3. If a branch instruction (Bcc, BSR), jump instruction (JMP, JSR), RTS instruction, or RTE instruction is located immediately before the address set in BAR, execution of this instruction will output a prefetch signal for that address, and an address break may be requested. This can be prevented by not making a break address setting for an address immediately following one of these instructions, or by determining within the interrupt handling routine whether interrupt handling was initiated by a genuine condition occurrence.
4. As an address break interrupt is generated by a combination of the internal prefetch signal and address, the timing of the start of interrupt exception handling depends on the content and execution cycle of the instruction at the set address and the preceding instruction. Figure 5.6 shows some address timing examples.

- Program area in on-chip memory, 1-state execution instruction at specified break address



- Program area in on-chip memory, 2-state execution instruction at specified break address



- Program area in external memory (2-state access, 16-bit-bus access), 1-state execution instruction at specified break address

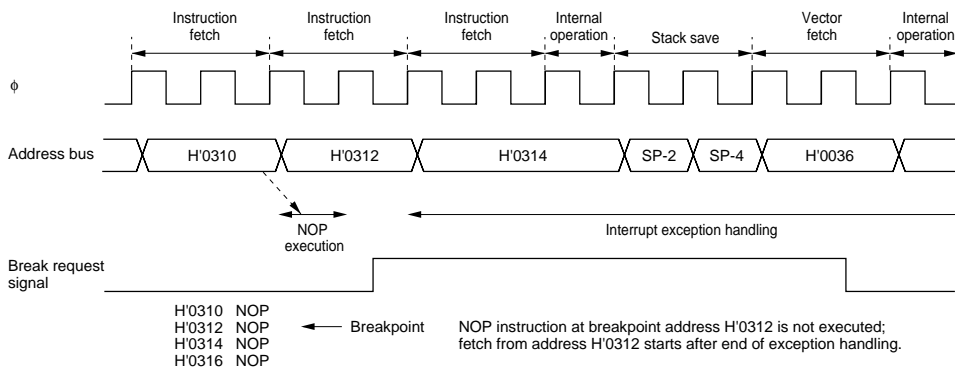


Figure 5.6 Examples of Address Break Timing

5.5 Interrupt Operation

5.5.1 Interrupt Control Modes and Interrupt Operation

Interrupt operations in the H8S/2138 Group and H8S/2134 Group differ depending on the interrupt control mode.

NMI and address break interrupts are accepted at all times except in the reset state and the hardware standby state. In the case of IRQ interrupts and on-chip supporting module interrupts, an enable bit is provided for each interrupt. Clearing an enable bit to 0 disables the corresponding interrupt request. Interrupt sources for which the enable bits are set to 1 are controlled by the interrupt controller.

Table 5.5 shows the interrupt control modes.

The interrupt controller performs interrupt control according to the interrupt control mode set by the INTM1 and INTM0 bits in SYSCR, the priorities set in ICR, and the masking state indicated by the I and UI bits in the CPU's CCR.

Table 5.5 Interrupt Control Modes

| Interrupt Control Mode | SYSCR | | Priority Setting Register | Interrupt Mask Bits | Description |
|------------------------|-------|-------|---------------------------|---------------------|--|
| | INTM1 | INTM0 | | | |
| 0 | 0 | 0 | ICR | I | Interrupt mask control is performed by the I bit Priority can be set with ICR |
| 1 | | 1 | ICR | I, UI | 3-level interrupt mask control is performed by the I and UI bits Priority can be set with ICR |

Figure 5.7 shows a block diagram of the priority decision circuit.

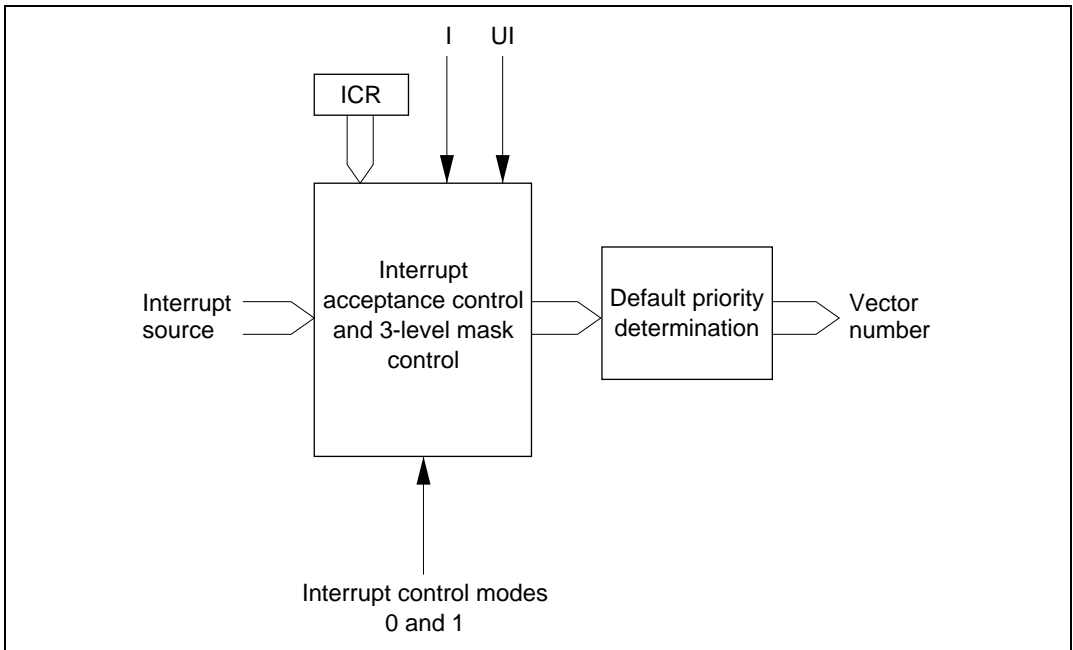


Figure 5.7 Block Diagram of Interrupt Control Operation

Interrupt Acceptance Control and 3-Level Control: In interrupt control modes 0 and 1, interrupt acceptance control and 3-level mask control is performed by means of the I and UI bits in CCR, and ICR (control level).

Table 5.6 shows the interrupts selected in each interrupt control mode.

Table 5.6 Interrupts Selected in Each Interrupt Control Mode

| Interrupt Control Mode | Interrupt Mask Bits | | Selected Interrupts |
|------------------------|---------------------|----|---|
| | I | UI | |
| 0 | 0 | * | All interrupts (control level 1 has priority) |
| | 1 | * | NMI and address break interrupts |
| 1 | 0 | * | All interrupts (control level 1 has priority) |
| | 1 | 0 | NMI, address break and control level 1 interrupts |
| | 1 | 1 | NMI and address break interrupts |

Legend:

*: Don't care

Default Priority Determination: The priority is determined for the selected interrupt, and a vector number is generated.

If the same value is set for ICR, acceptance of multiple interrupts is enabled, and so only the interrupt source with the highest priority according to the preset default priorities is selected and has a vector number generated.

Interrupt sources with a lower priority than the accepted interrupt source are held pending.

Table 5.7 shows operations and control signal functions in each interrupt control mode.

Table 5.7 Operations and Control Signal Functions in Each Interrupt Control Mode

| Interrupt Control Mode | Setting | | Interrupt Acceptance Control 3-Level Control | | | Default Priority Determination | T (Trace) | |
|------------------------|---------|-------|---|----|-----|--------------------------------|-----------|---|
| | INTM1 | INTM0 | I | UI | ICR | | | |
| 0 | 0 | 0 | O | IM | — | PR | O | — |
| 1 | | 1 | O | IM | IM | PR | O | — |

Legend:

O: Interrupt operation control performed

IM: Used as interrupt mask bit

PR: Sets priority

—: Not used

5.5.2 Interrupt Control Mode 0

Enabling and disabling of IRQ interrupts and on-chip supporting module interrupts can be set by means of the I bit in the CPU's CCR, and ICR. Interrupts are enabled when the I bit is cleared to 0, and disabled when set to 1. Control level 1 interrupt sources have higher priority.

Figure 5.8 shows a flowchart of the interrupt acceptance operation in this case.

1. If an interrupt source occurs when the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
2. When interrupt requests are sent to the interrupt controller, a control level 1 interrupt, according to the control level set in ICR, has priority for selection, and other interrupt requests are held pending. If a number of interrupt requests with the same control level setting are generated at the same time, the interrupt request with the highest priority according to the priority system shown in table 5.4 is selected.
3. The I bit is then referenced. If the I bit is cleared to 0, the interrupt request is accepted. If the I bit is set to 1, only NMI and address break interrupts are accepted, and other interrupt requests are held pending.
4. When an interrupt request is accepted, interrupt exception handling starts after execution of the current instruction has been completed.
5. The PC and CCR are saved to the stack area by interrupt exception handling. The PC saved on the stack shows the address of the first instruction to be executed after returning from the interrupt handling routine.
6. Next, the I bit in CCR is set to 1. This disables all interrupts except NMI and address break interrupts.
7. A vector address is generated for the accepted interrupt, and execution of the interrupt handling routine starts at the address indicated by the contents of that vector address.

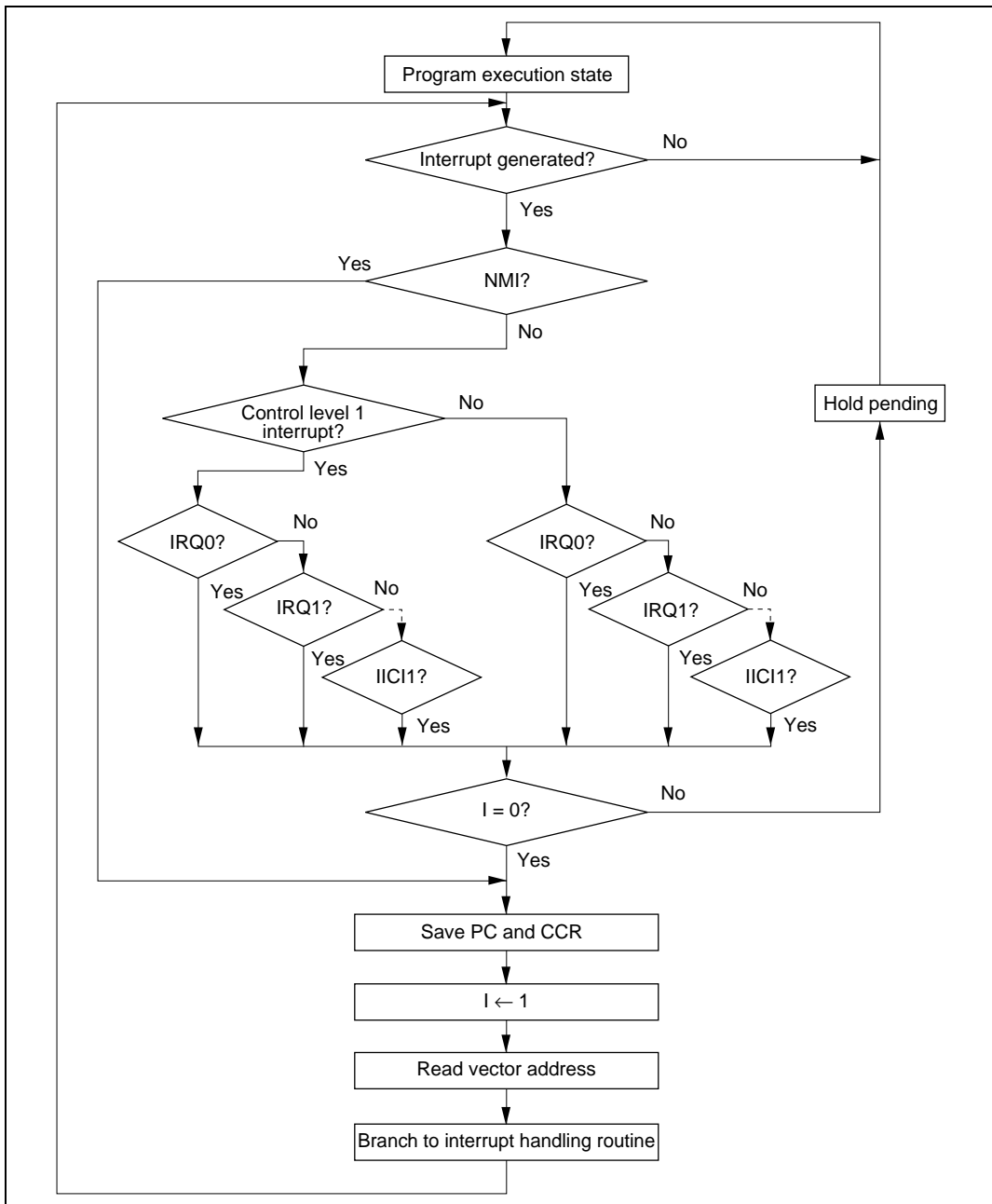


Figure 5.8 Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 0

5.5.3 Interrupt Control Mode 1

Three-level masking is implemented for IRQ interrupts and on-chip supporting module interrupts by means of the I and UI bits in the CPU's CCR, and ICR.

- Control level 0 interrupt requests are enabled when the I bit is cleared to 0, and disabled when set to 1.
- Control level 1 interrupt requests are enabled when the I bit or UI bit is cleared to 0, and disabled when both the I bit and the UI bit are set to 1.

For example, if the interrupt enable bit for an interrupt request is set to 1, and H'20, H'00, and H'00 are set in ICRA, ICRB, and ICRC, respectively, (i.e. IRQ2 and IRQ3 interrupts are set to control level 1 and other interrupts to control level 0), the situation is as follows:

- When $I = 0$, all interrupts are enabled
(Priority order: NMI > IRQ2 > IRQ3 > address break > IRQ0 > IRQ1 ...)
- When $I = 1$ and $UI = 0$, only NMI, IRQ2, IRQ3, and address break interrupts are enabled
- When $I = 1$ and $UI = 1$, only NMI and address break interrupts are enabled

Figure 5.9 shows the state transitions in these cases.

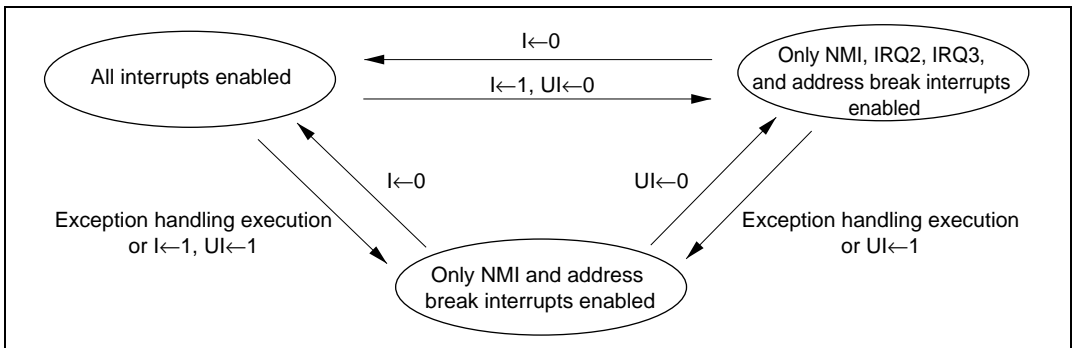


Figure 5.9 Example of State Transitions in Interrupt Control Mode 1

Figure 5.10 shows a flowchart of the interrupt acceptance operation in this case.

1. If an interrupt source occurs when the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
2. When interrupt requests are sent to the interrupt controller, a control level 1 interrupt, according to the control level set in ICR, has priority for selection, and other interrupt requests are held pending. If a number of interrupt requests with the same control level setting are generated at the same time, the interrupt request with the highest priority according to the priority system shown in table 5.4 is selected.
3. The I bit is then referenced. If the I bit is cleared to 0, the UI bit has no effect.
An interrupt request set to interrupt control level 0 is accepted when the I bit is cleared to 0. If the I bit is set to 1, only NMI and address break interrupts are accepted, and other interrupt requests are held pending.
An interrupt request set to interrupt control level 1 has priority over an interrupt request set to interrupt control level 0, and is accepted if the I bit is cleared to 0, or if the I bit is set to 1 and the UI bit is cleared to 0.
When both the I bit and the UI bit are set to 1, only NMI and address break interrupts are accepted, and other interrupt requests are held pending.
4. When an interrupt request is accepted, interrupt exception handling starts after execution of the current instruction has been completed.
5. The PC and CCR are saved to the stack area by interrupt exception handling. The PC saved on the stack shows the address of the first instruction to be executed after returning from the interrupt handling routine.
6. Next, the I and UI bits in CCR are set to 1. This disables all interrupts except NMI and address break.
7. A vector address is generated for the accepted interrupt, and execution of the interrupt handling routine starts at the address indicated by the contents of that vector address.

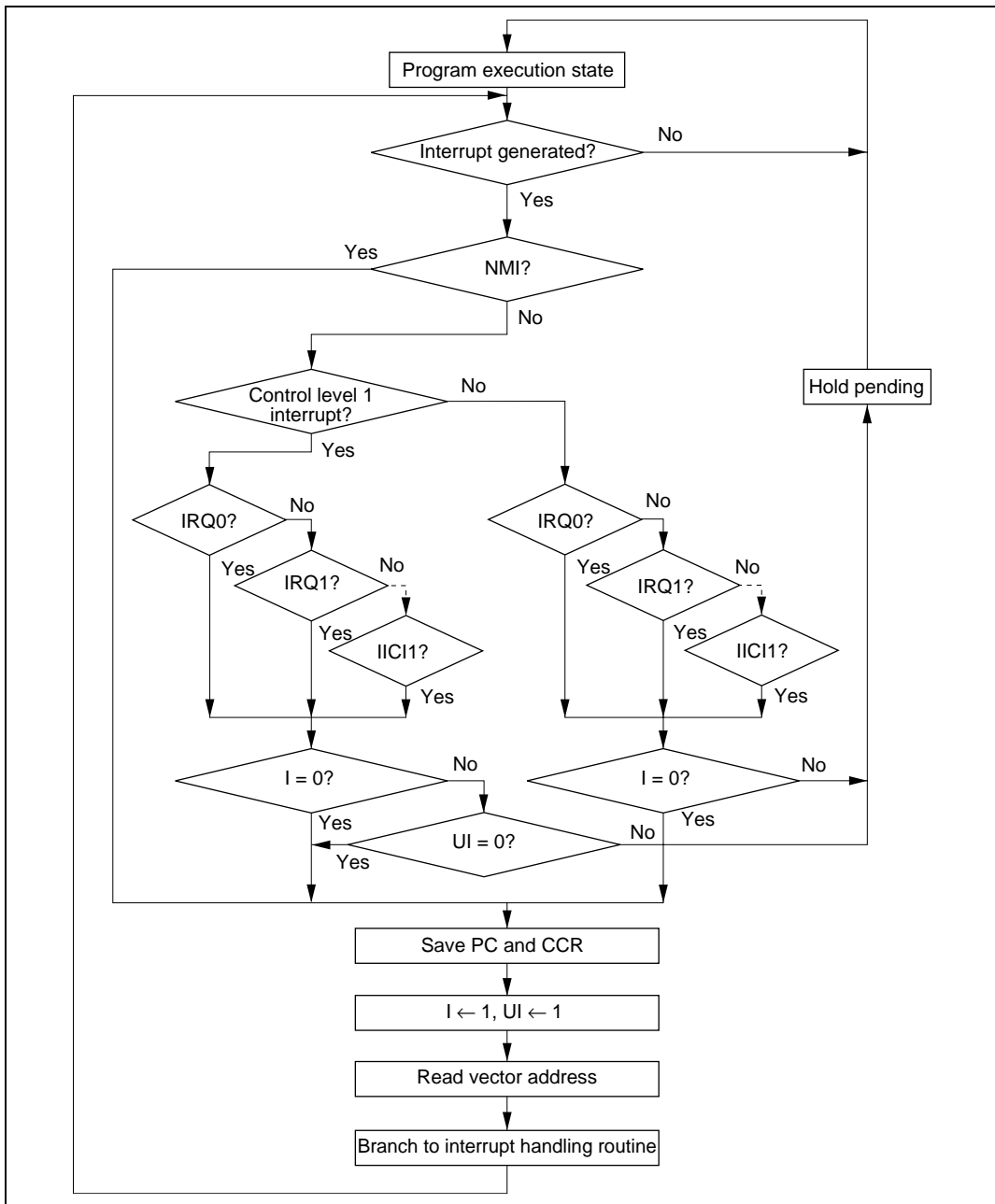


Figure 5.10 Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 1

5.5.4 Interrupt Exception Handling Sequence

Figure 5.11 shows the interrupt exception handling sequence. The example shown is for the case where interrupt control mode 0 is set in advanced mode, and the program area and stack area are in on-chip memory.

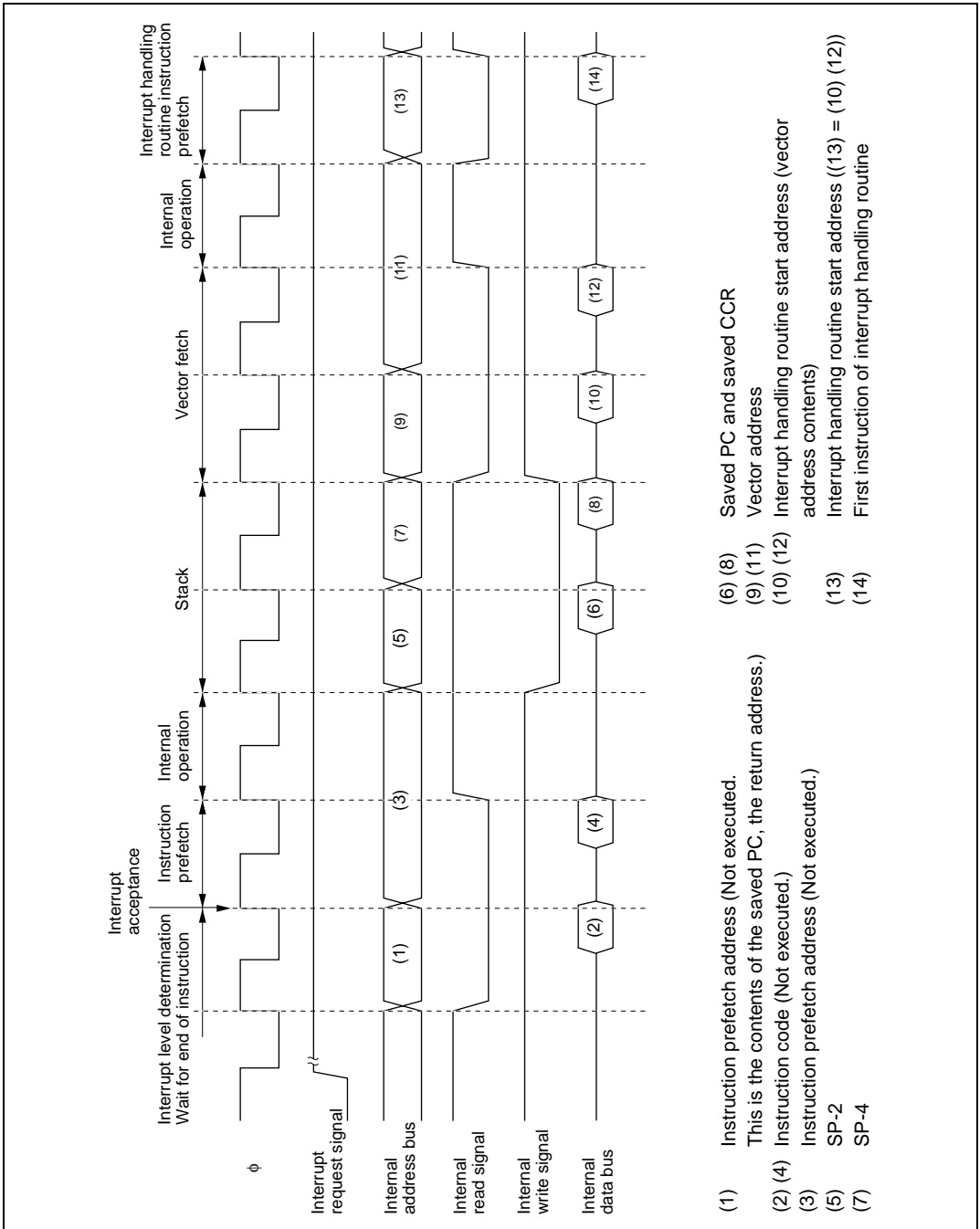


Figure 5.11 Interrupt Exception Handling

5.5.5 Interrupt Response Times

The H8S/2138 Group and H8S/2134 Group are capable of fast word access to on-chip memory, and high-speed processing can be achieved by providing the program area in on-chip ROM and the stack area in on-chip RAM.

Table 5.8 shows interrupt response times—the interval between generation of an interrupt request and execution of the first instruction in the interrupt handling routine. The symbols used in table 5.8 are explained in table 5.9.

Table 5.8 Interrupt Response Times

| No. | Item | Number of States | |
|------------------------------|--|------------------------|------------------------|
| | | Normal Mode | Advanced Mode |
| 1 | Interrupt priority determination* ¹ | 3 | 3 |
| 2 | Number of wait states until executing instruction ends* ² | 1 to $(19+2\cdot S_i)$ | 1 to $19+(2\cdot S_i)$ |
| 3 | PC, CCR stack save | $2\cdot S_k$ | $2\cdot S_k$ |
| 4 | Vector fetch | S_i | $2\cdot S_i$ |
| 5 | Instruction fetch* ³ | $2\cdot S_i$ | $2\cdot S_i$ |
| 6 | Internal processing* ⁴ | 2 | 2 |
| Total (using on-chip memory) | | 11 to 31 | 12 to 32 |

Notes: 1. Two states in case of internal interrupt.
 2. Refers to MULXS and DIVXS instructions.
 3. Prefetch after interrupt acceptance and interrupt handling routine prefetch.
 4. Internal processing after interrupt acceptance and internal processing after vector fetch.

Table 5.9 Number of States in Interrupt Handling Routine Execution

| | Symbol | Internal Memory | Object of Access | |
|---------------------|--------|-----------------|------------------|----------------|
| | | | External Device | |
| | | | 8-Bit Bus | |
| | | | 2-State Access | 3-State Access |
| Instruction fetch | S_i | 1 | 4 | $6+2m$ |
| Branch address read | S_j | | | |
| Stack manipulation | S_k | | | |

Legend:

m: Number of wait states in an external device access

5.6 Usage Notes

5.6.1 Contention between Interrupt Generation and Disabling

When an interrupt enable bit is cleared to 0 to disable interrupts, the disabling becomes effective after execution of the instruction.

In other words, when an interrupt enable bit is cleared to 0 by an instruction such as BCLR or MOV, if an interrupt is generated during execution of the instruction, the interrupt concerned will still be enabled on completion of the instruction, and so interrupt exception handling for that interrupt will be executed on completion of the instruction. However, if there is an interrupt request of higher priority than that interrupt, interrupt exception handling will be executed for the higher-priority interrupt, and the lower-priority interrupt will be ignored.

The same also applies when an interrupt source flag is cleared to 0.

Figure 5.12 shows an example in which the CMIEA bit in 8-bit timer register TCR is cleared to 0.

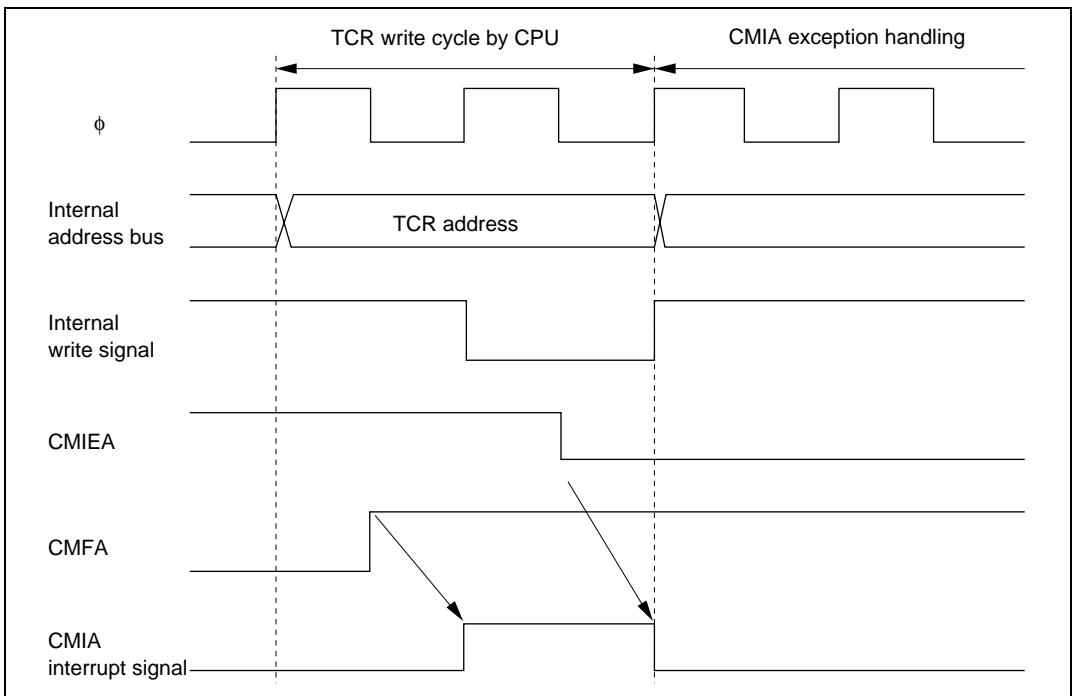


Figure 5.12 Contention between Interrupt Generation and Disabling

The above contention will not occur if an enable bit or interrupt source flag is cleared to 0 while the interrupt is masked.

5.6.2 Instructions that Disable Interrupts

Instructions that disable interrupts are LDC, ANDC, ORC, and XORC. After any of these instructions is executed, all interrupts, including NMI, are disabled, and the next instruction is always executed. When the I bit or UI bit is set by one of these instructions, the new value becomes valid two states after execution of the instruction ends.

5.6.3 Interrupts during Execution of EEPMOV Instruction

Interrupt operation differs between the EEPMOV.B instruction and the EEPMOV.W instruction.

With the EEPMOV.B instruction, an interrupt request (including NMI) issued during the transfer is not accepted until the move is completed.

With the EEPMOV.W instruction, if an interrupt request is issued during the transfer, interrupt exception handling starts at a break in the transfer cycle. The PC value saved on the stack in this case is the address of the next instruction.

Therefore, if an interrupt is generated during execution of an EEPMOV.W instruction, the following coding should be used.

```
L1:   EEPMOV.W
      MOV.W   R4, R4
      BNE    L1
```

5.7 DTC Activation by Interrupt

5.7.1 Overview

The DTC can be activated by an interrupt. In this case, the following options are available:

- Interrupt request to CPU
- Activation request to DTC
- Both of the above

For details of interrupt requests that can be used to activate the DTC, see section 7, Data Transfer Controller [H8S/2138 Group].

5.7.2 Block Diagram

Figure 5.13 shows a block diagram of the DTC and interrupt controller.

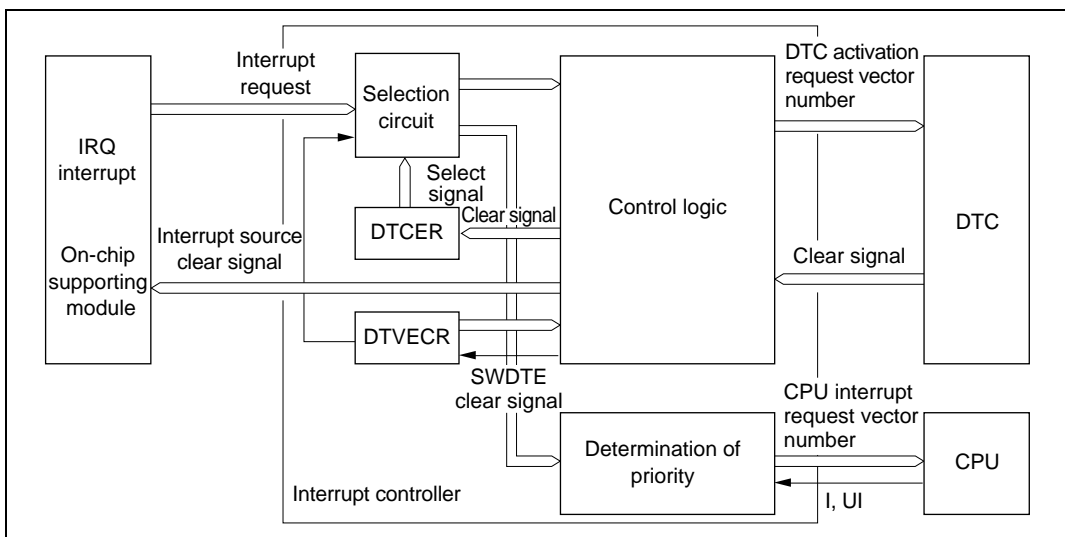


Figure 5.13 Interrupt Control for DTC

5.7.3 Operation

The interrupt controller has three main functions in DTC control.

Selection of Interrupt Source: It is possible to select DTC activation request or CPU interrupt request with the DTCE bit of DTCERA to DTCERE in the DTC.

After a DTC data transfer, the DTCE bit can be cleared to 0 and an interrupt request sent to the CPU in accordance with the specification of the DISEL bit of MRB in the DTC.

When the DTC performs the specified number of data transfers and the transfer counter reaches 0, following the DTC data transfer the DTCE bit is cleared to 0 and an interrupt request is sent to the CPU.

Determination of Priority: The DTC activation source is selected in accordance with the default priority order, and is not affected by mask or priority levels. See section 7.3.3, DTC Vector Table, for the respective priorities.

Operation Order: If the same interrupt is selected as a DTC activation source and a CPU interrupt source, the DTC data transfer is performed first, followed by CPU interrupt exception handling.

Table 5.10 summarizes interrupt source selection and interrupt source clearance control according to the settings of the DTCE bit of DTCERA to DTCERE in the DTC and the DISEL bit of MRB in the DTC.

Table 5.10 Interrupt Source Selection and Clearing Control

| Settings | | Interrupt Source Selection/Clearing Control | |
|----------|-------|---|-----|
| DTC | | DTC | CPU |
| DTCE | DISEL | | |
| 0 | * | × | Δ |
| 1 | 0 | Δ | × |
| | 1 | ○ | Δ |

Legend:

Δ: The relevant interrupt is used. Interrupt source clearing is performed.
(The CPU should clear the source flag in the interrupt handling routine.)

○: The relevant interrupt is used. The interrupt source is not cleared.

×: The relevant bit cannot be used.

*: Don't care

Usage Note: SCI, IIC, and A/D converter interrupt sources are cleared when the DTC reads or writes to the prescribed register, and are not dependent upon the DISEL bit.

Section 6 Bus Controller

6.1 Overview

The H8S/2138 Group and H8S/2134 Group have an on-chip bus controller (BSC) that allows external address space bus specifications, such as bus width and number of access states, to be set.

The bus controller also has a bus arbitration function, and controls the operation of the internal bus masters: the CPU and data transfer controller (DTC).

6.1.1 Features

The features of the bus controller are listed below.

- Basic bus interface
 - 2-state access or 3-state access can be selected
 - Program wait states can be inserted
- Burst ROM interface
 - External space can be designated as ROM interface space
 - 1-state or 2-state burst access can be selected
- Idle cycle insertion
 - An idle cycle can be inserted when an external write cycle immediately follows an external read cycle
- Bus arbitration function
 - Includes a bus arbiter that arbitrates bus mastership between the CPU and DTC

6.1.2 Block Diagram

Figure 6.1 shows a block diagram of the bus controller.

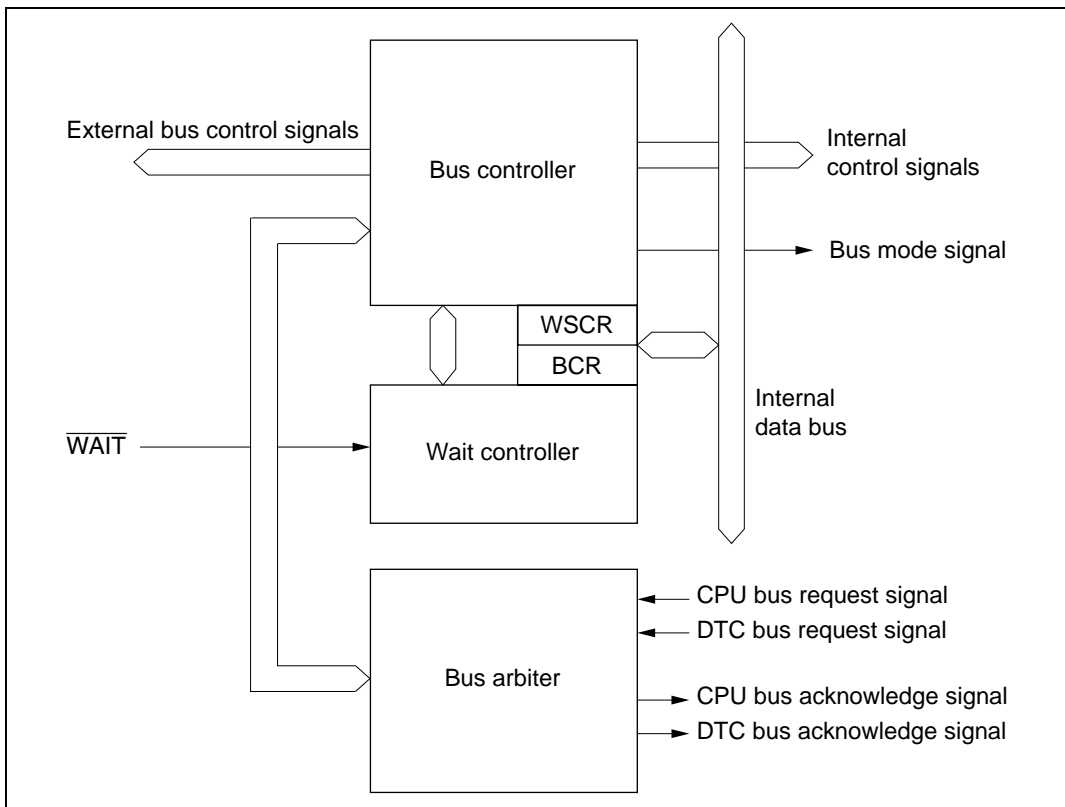


Figure 6.1 Block Diagram of Bus Controller

6.1.3 Pin Configuration

Table 6.1 summarizes the pins of the bus controller.

Table 6.1 Bus Controller Pins

| Name | Symbol | I/O | Function |
|----------------|-------------------|--------|--|
| Address strobe | \overline{AS} | Output | Strobe signal indicating that address output on address bus is enabled (when IOSE bit is 0) |
| I/O select | \overline{IOS} | Output | I/O select signal (when IOSE bit is 1) |
| Read | \overline{RD} | Output | Strobe signal indicating that external space is being read |
| Write | \overline{WR} | Output | Strobe signal indicating that external space is being written to, and that data bus is enabled |
| Wait | \overline{WAIT} | Input | Wait request signal when external 3-state access space is accessed |

6.1.4 Register Configuration

Table 6.2 summarizes the registers of the bus controller.

Table 6.2 Bus Controller Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|-----------------------------|--------------|-----|---------------|----------|
| Bus control register | BCR | R/W | H'D7 | H'FFC6 |
| Wait state control register | WSCR | R/W | H'33 | H'FFC7 |

Note: * Lower 16 bits of the address.

6.2 Register Descriptions

6.2.1 Bus Control Register (BCR)

| | | | | | | | | |
|---------------|-------|-------|--------|--------|--------|-----|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICIS1 | ICIS0 | BRSTRM | BRSTS1 | BRSTS0 | — | IOS1 | IOS0 |
| Initial value | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

BCR is an 8-bit readable/writable register that specifies the external memory space access mode, and the extent of the I/O area when the I/O strobe function has been selected for the \overline{AS} pin.

BCR is initialized to H'D7 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Idle Cycle Insert 1 (ICIS1): Reserved. Do not write 0 to this bit.

Bit 6—Idle Cycle Insert 0 (ICIS0): Selects whether or not a one-state idle cycle is to be inserted between bus cycles when successive external read and external write cycles are performed.

Bit 6

| ICIS0 | Description |
|-------|--|
| 0 | Idle cycle not inserted in case of successive external read and external write cycles |
| 1 | Idle cycle inserted in case of successive external read and external write cycles (Initial value) |

Bit 5—Burst ROM Enable (BRSTRM): Selects whether external space is designated as a burst ROM interface space. The selection applies to the entire external space .

Bit 5

| BRSTRM | Description |
|--------|--|
| 0 | Basic bus interface (Initial value) |
| 1 | Burst ROM interface |

Bit 4—Burst Cycle Select 1 (BRSTS1): Selects the number of burst cycles for the burst ROM interface.

Bit 4

| BRSTS1 | Description |
|--------|--|
| 0 | Burst cycle comprises 1 state |
| 1 | Burst cycle comprises 2 states (Initial value) |

Bit 3—Burst Cycle Select 0 (BRSTS0): Selects the number of words that can be accessed in a burst ROM interface burst access.

Bit 3

| BRSTS0 | Description |
|--------|--|
| 0 | Max. 4 words in burst access (Initial value) |
| 1 | Max. 8 words in burst access |

Bit 2—Reserved: Do not write 0 to this bit.

Bits 1 and 0—IOS Select 1 and 0 (IOS1, IOS0): See table 6.4.

6.2.2 Wait State Control Register (WSCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-----|-----|------|------|-----|-----|
| | RAMS | RAM0 | ABW | AST | WMS1 | WMS0 | WC1 | WC0 |
| Initial value | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

WSCR is an 8-bit readable/writable register that specifies the data bus width, number of access states, wait mode, and number of wait states for external memory space. The on-chip memory and internal I/O register bus width and number of access states are fixed, irrespective of the WSCR settings.

WSCR is initialized to H'33 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—RAM Select (RAMS)/Bit 6—RAM Area Setting (RAM0): These are reserved bits. Always write 0 when writing to these bits in the A-mask version.

Bit 5—Bus Width Control (ABW): Specifies whether the external memory space is 8-bit access space or 16-bit access space.

However, a 16-bit access space cannot be specified for these group, and therefore 0 should not be written to this bit.

Bit 5

| ABW | Description |
|-----|--|
| 0 | External memory space is designated as 16-bit access space (A 16-bit access space cannot be specified for these group) |
| 1 | External memory space is designated as 8-bit access space (Initial value) |

Bit 4—Access State Control (AST): Specifies whether the external memory space is 2-state access space or 3-state access space, and simultaneously enables or disables wait state insertion.

Bit 4

| AST | Description |
|-----|--|
| 0 | External memory space is designated as 2-state access space Wait state insertion in external memory space accesses is disabled |
| 1 | External memory space is designated as 3-state access space (Initial value) Wait state insertion in external memory space accesses is enabled |

Bits 3 and 2—Wait Mode Select 1 and 0 (WMS1, WMS0): These bits select the wait mode when external memory space is accessed while the AST bit is set to 1.

| Bit 3 | Bit 2 | Description |
|-------|-------|-----------------------------------|
| WMS1 | WMS0 | |
| 0 | 0 | Program wait mode (Initial value) |
| | 1 | Wait-disabled mode |
| 1 | 0 | Pin wait mode |
| | 1 | Pin auto-wait mode |

Bits 1 and 0—Wait Count 1 and 0 (WC1, WC0): These bits select the number of program wait states when external memory space is accessed while the AST bit is set to 1.

| Bit 1 | Bit 0 | |
|-------|-------|---|
| WC1 | WC0 | Description |
| 0 | 0 | No program wait states are inserted |
| | 1 | 1 program wait state is inserted in external memory space accesses |
| 1 | 0 | 2 program wait states are inserted in external memory space accesses |
| | 1 | 3 program wait states are inserted in external memory space accesses (Initial value) |

6.3 Overview of Bus Control

6.3.1 Bus Specifications

The external space bus specifications consist of three elements: bus width, number of access states, and wait mode and number of program wait states.

The bus width and number of access states for on-chip memory and internal I/O registers are fixed, and are not affected by the bus controller.

Bus Width: A bus width of 8 or 16 bits can be selected with the ABW bit. A 16-bit access space cannot be specified for these group.

Number of Access States: Two or three access states can be selected with the AST bit.

When 2-state access space is designated, wait insertion is disabled. The number of access states on the burst ROM interface is determined without regard to the AST bit setting.

Wait Mode and Number of Program Wait States: When 3-state access space is designated by the AST bit, the wait mode and the number of program wait states to be inserted automatically is selected with WMS1, WMS0, WC1, and WC0. From 0 to 3 program wait states can be selected.

Table 6.3 shows the bus specifications for each basic bus interface area.

Table 6.3 Bus Specifications for Each Area (Basic Bus Interface)

| ABW | AST | WMS1 | WMS0 | WC1 | WC0 | Bus Specifications (Basic Bus Interface) | | |
|-----|-----|------|------|-----|-----|---|---------------|---------------------|
| | | | | | | Bus Width | Access States | Program Wait States |
| 0 | 0 | — | — | — | — | Cannot be used in the H8S/2138 Group or H8S/2134 Group. | | |
| 1 | 0 | — | — | — | — | 8 | 2 | 0 |
| | | 1 | 0 | 1 | — | 8 | 3 | 0 |
| | —* | —* | 0 | 0 | | 3 | 0 | |
| | | | | 1 | | | 1 | |
| | | | | 1 | 0 | | 2 | |
| | | | | 1 | | 3 | | |

Note: * Except when WMS1 = 0 and WMS0 = 1

6.3.2 Advanced Mode

The H8S/2138 and H8S/2134 have 16 address output pins, so there are no pins for output of the upper address bits (A16 to A23) in advanced mode. H'FFF000 to H'FFFE4F (H'FFF000 to H'FFF7FF in the H8S/2138 F-ZTAT A mask version) can be accessed by designating the \overline{AS} pin as an I/O strobe pin. The accessible external space is therefore H'FFF000 to H'FFFE4F (H'FFF000 to H'FFF7FF in the H8S/2138 F-ZTAT A mask version) even when expanded mode with ROM enabled is selected in advanced mode.

The initial state of the external space is basic bus interface, three-state access space. In ROM-enabled expanded mode, the space excluding the on-chip ROM, on-chip RAM, and internal I/O registers is external space. The on-chip RAM is enabled when the RAME bit in the system control register (SYSCR) is set to 1; when the RAME bit is cleared to 0, the on-chip RAM is disabled and the corresponding space becomes external space.

6.3.3 Normal Mode

The initial state of the external memory space is basic bus interface, three-state access space. In ROM-disabled expanded mode, the space excluding the on-chip RAM and internal I/O registers is external space. In ROM-enabled expanded mode, the space excluding the on-chip ROM, on-chip RAM, and internal I/O registers is external space. The on-chip RAM is enabled when the RAME bit in the system control register (SYSCR) is set to 1; when the RAME bit is cleared to 0, the on-chip RAM is disabled and the corresponding space becomes external space.

6.3.4 I/O Select Signal

In the H8S/2138 Group and H8S/2134 Group, an I/O select signal ($\overline{\text{IOS}}$) can be output, with the signal output going low when the designated external space is accessed.

Figure 6.2 shows an example of $\overline{\text{IOS}}$ signal output timing.

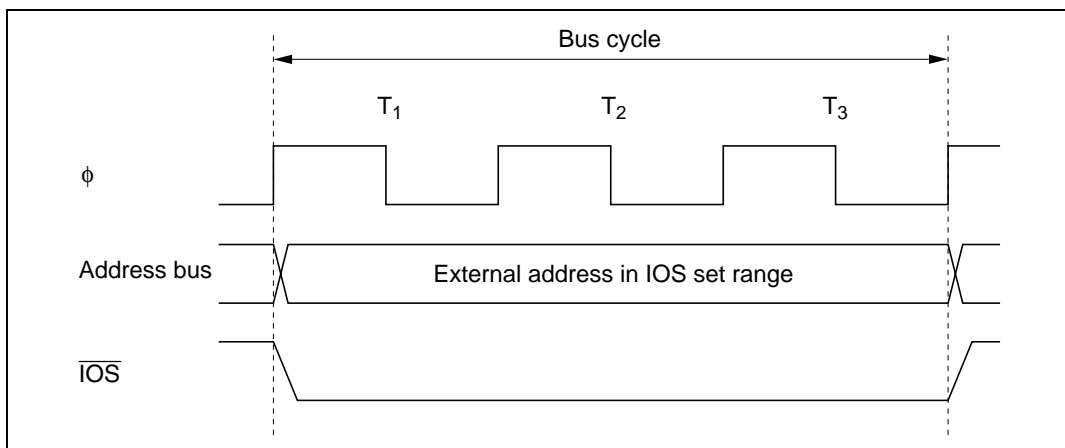


Figure 6.2 $\overline{\text{IOS}}$ Signal Output Timing

Enabling or disabling of $\overline{\text{IOS}}$ signal output is controlled by the setting of the IOSE bit in SYSCR. In expanded mode, this pin operates as the $\overline{\text{AS}}$ output pin after a reset, and therefore the IOSE bit in SYSCR must be set to 1 in order to use this pin as the $\overline{\text{IOS}}$ signal output. See section 8, I/O Ports, for details.

The range of addresses for which the $\overline{\text{IOS}}$ signal is output can be set with bits IOS1 and IOS0 in BCR. The $\overline{\text{IOS}}$ signal address ranges are shown in table 6.4.

Table 6.4 $\overline{\text{IOS}}$ Signal Output Range Settings

| IOS1 | IOS0 | $\overline{\text{IOS}}$ Signal Output Range |
|------|------|---|
| 0 | 0 | H'(FF)F000 to H'(FF)F03F |
| | 1 | H'(FF)F000 to H'(FF)F0FF |
| 1 | 0 | H'(FF)F000 to H'(FF)F3FF |
| | 1 | H'(FF)F000 to H'(FF)FE4F* (Initial value) |

Note: * In the H8S/2138 F-ZTAT A-mask version, the address range is from H'(FF)F000 to H'(FF)F7FF.

6.4 Basic Bus Interface

6.4.1 Overview

The basic bus interface enables direct connection of ROM, SRAM, and so on.

The bus specifications can be selected with the AST bit, and the WMS1, WMS0, WC1, and WC0 bits (see table 6.3).

6.4.2 Data Size and Data Alignment

Data sizes for the CPU and other internal bus masters are byte, word, and longword. The bus controller has a data alignment function, and when accessing external space, controls whether the upper data bus (D15 to D8) or lower data bus (D7 to D0) is used according to the bus specifications for the area being accessed (8-bit access space or 16-bit access space) and the data size.

These group only have an upper data bus, and only 8-bit access space alignment is used. In these group, the upper data bus pins are designated D7 to D0.

8-Bit Access Space: Figure 6.3 illustrates data alignment control for the 8-bit access space. With the 8-bit access space, the upper data bus (D15 to D8) is always used for accesses. The amount of data that can be accessed at one time is one byte: a word access is performed as two byte accesses, and a longword access, as four byte accesses.

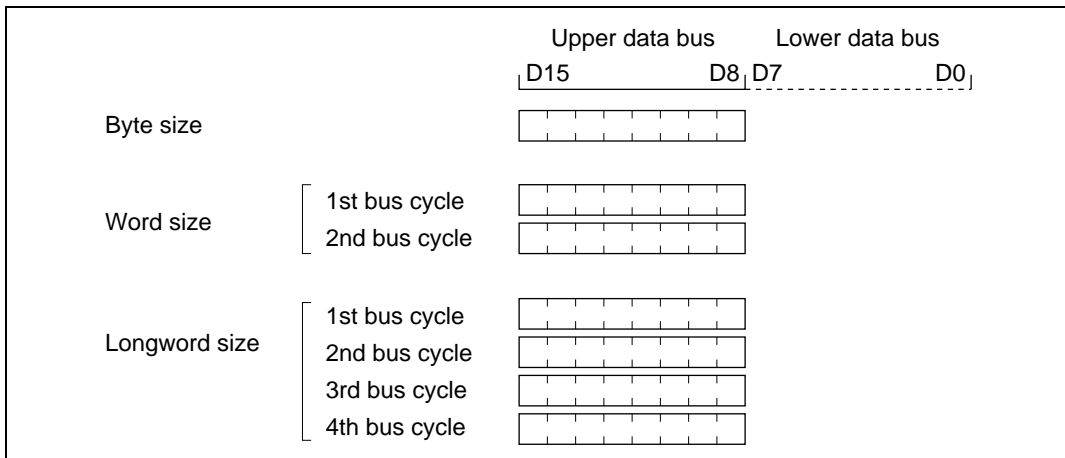


Figure 6.3 Access Sizes and Data Alignment Control (8-Bit Access Space)

16-Bit Access Space (Cannot Be Used in the H8S/2138 Group or H8S/2134 Group): Figure 6.4 illustrates data alignment control for the 16-bit access space. With the 16-bit access space, the upper data bus (D15 to D8) and lower data bus (D7 to D0) are used for accesses. The amount of data that can be accessed at one time is one byte or one word, and a longword access is executed as two word accesses.

In byte access, whether the upper or lower data bus is used is determined by whether the address is even or odd. The upper data bus is used for an even address, and the lower data bus for an odd address.

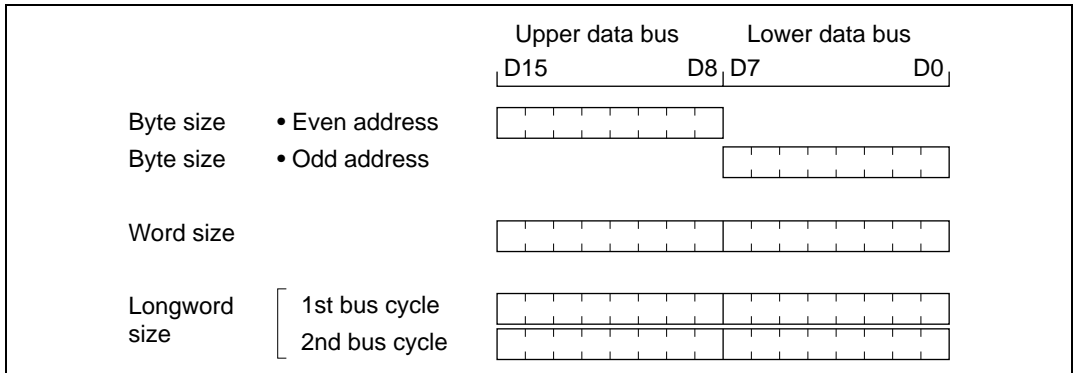


Figure 6.4 Access Sizes and Data Alignment Control (16-Bit Access Space)

6.4.3 Valid Strobes

Table 6.5 shows the data buses used and valid strobes for the access spaces.

In a read, the $\overline{\text{RD}}$ signal is valid without discrimination between the upper and lower halves of the data bus.

In a write, the $\overline{\text{HWR}}$ signal is valid for the upper half of the data bus, and the $\overline{\text{LWR}}$ signal for the lower half.

These group only have an upper data bus, and only the $\overline{\text{RD}}$ and $\overline{\text{HWR}}$ signals are valid. In these group, the $\overline{\text{HWR}}$ signal pin is designated WR.

Table 6.5 Data Buses Used and Valid Strobes

| Area | Access Size | Read/Write | Address | Valid Strobe | Upper Data Bus (D15 to D8) ^{*1} | Lower Data Bus (D7 to D0) ^{*3} |
|--|-------------|------------|--|--------------------------------|--|---|
| 8-bit access space | Byte | Read | — | \overline{RD} | Valid | Port, etc. |
| | | Write | — | \overline{HWR} ^{*2} | | Port, etc. |
| 16-bit access space (Cannot be used in the H8S/2138 Group or H8S/2134 Group) | Byte | Read | Even | \overline{RD} | Valid | Invalid |
| | | | Odd | | Invalid | Valid |
| | Write | Even | \overline{HWR} | Valid | Undefined | |
| | | Odd | \overline{LWR} | Undefined | Valid | |
| Word | Read | — | \overline{RD} | Valid | Valid | |
| | Write | — | \overline{HWR} , \overline{LWR} | Valid | Valid | |

Notes: Undefined: Undefined data is output.

Invalid: Input state; input value is ignored.

Port, etc.: Pins are used as port or on-chip supporting module input/output pins, and not as data bus pins.

1. The pin names in these group are D7 to D0.
2. The pin name in these group is \overline{WR} .
3. There are no lower data bus pins in these group.

6.4.4 Basic Timing

8-Bit 2-State Access Space: Figure 6.5 shows the bus timing for an 8-bit 2-state access space. When an 8-bit access space is accessed, the upper half (D15 to D8) of the data bus is used.

Wait states cannot be inserted.

These group have no lower data bus (D7 to D0) pins or \overline{LWR} pin. In these group, the upper data bus (D15 to D8) pins are designated D7 to D0, and the \overline{HWR} signal pin is designated \overline{WR} .

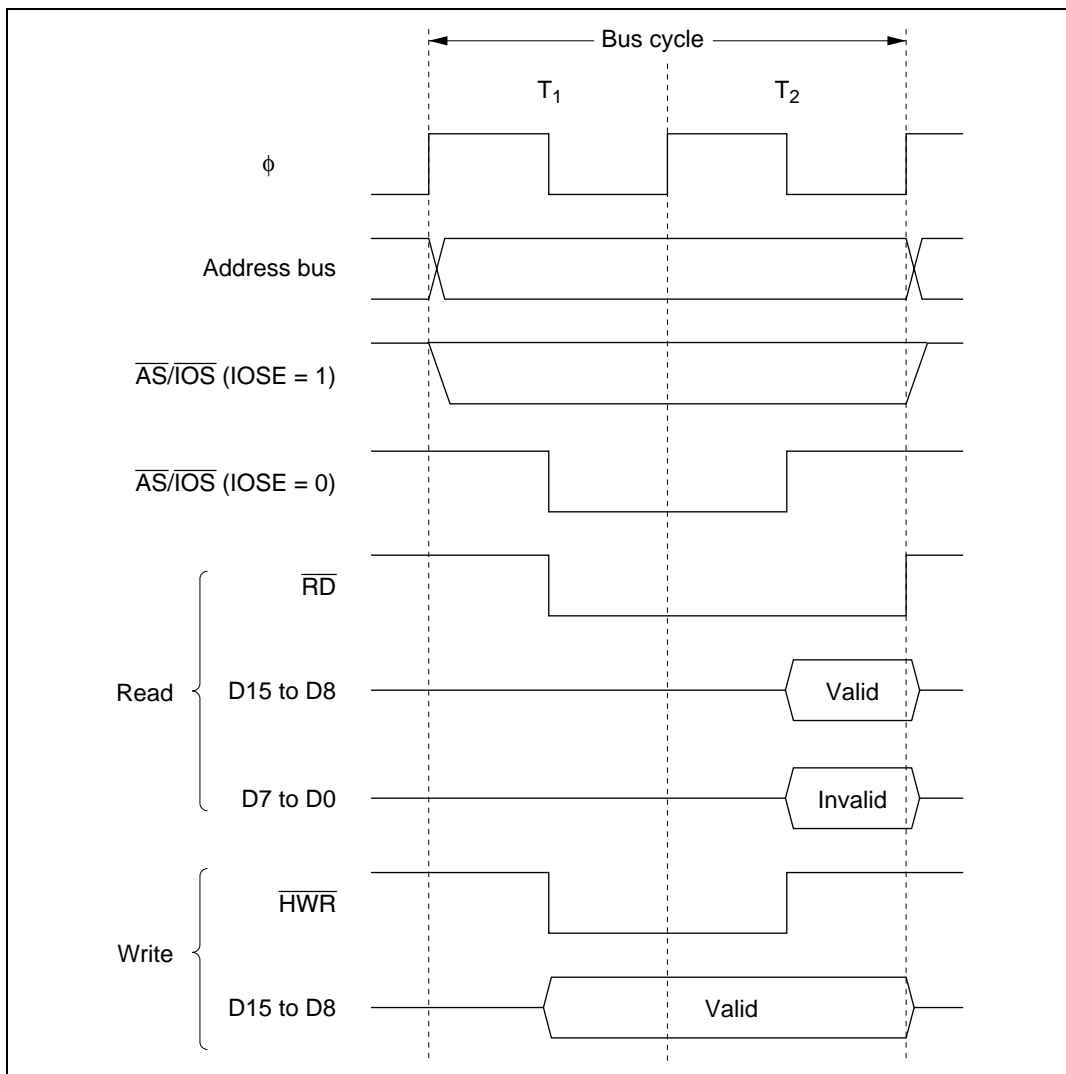


Figure 6.5 Bus Timing for 8-Bit 2-State Access Space

8-Bit 3-State Access Space: Figure 6.6 shows the bus timing for an 8-bit 3-state access space. When an 8-bit access space is accessed, the upper half (D15 to D8) of the data bus is used.

Wait states can be inserted.

These group have no lower data bus (D7 to D0) pins or $\overline{\text{LWR}}$ pin. In these group, the upper data bus (D15 to D8) pins are designated D7 to D0, and the $\overline{\text{HWR}}$ signal pin is designated $\overline{\text{WR}}$.

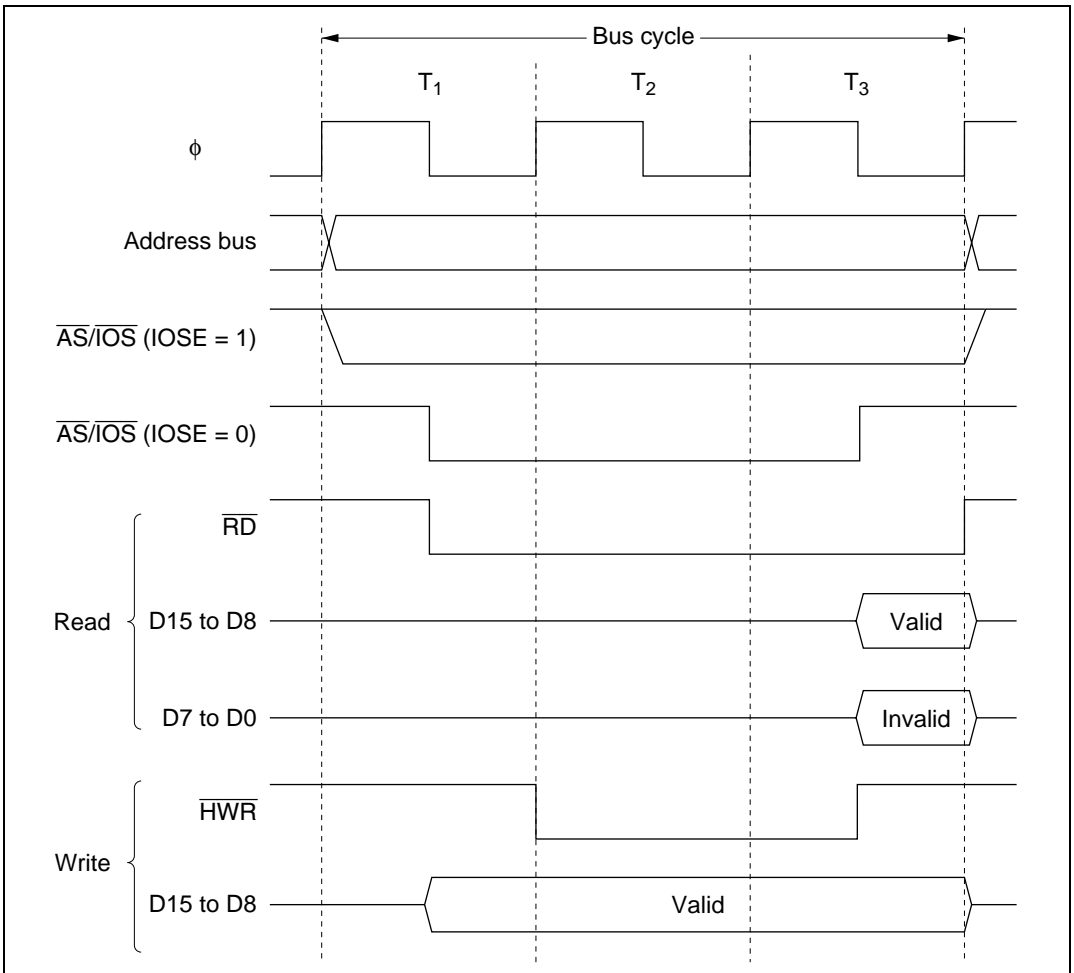


Figure 6.6 Bus Timing for 8-Bit 3-State Access Space

6.4.5 Wait Control

When accessing external space, the MCU can extend the bus cycle by inserting one or more wait states (T_w). There are three ways of inserting wait states: program wait insertion, pin wait insertion using the $\overline{\text{WAIT}}$ pin, and a combination of the two.

Program Wait Mode

In program wait mode, the number of T_w states specified by bits WC1 and WC0 are always inserted between the T_2 and T_3 states when external space is accessed.

Pin Wait Mode

In pin wait mode, the number of T_w states specified by bits WC1 and WC0 are always inserted between the T_2 and T_3 states when external space is accessed. If the $\overline{\text{WAIT}}$ pin is low at the fall of ϕ in the last T_2 or T_w state, another T_w state is inserted. If the $\overline{\text{WAIT}}$ pin is held low, T_w states are inserted until it goes high.

Pin wait mode is useful for inserting four or more wait states, or for changing the number of T_w states for different external devices.

Pin Auto-Wait Mode

In pin auto-wait mode, if the $\overline{\text{WAIT}}$ pin is low at the fall of the system clock in the T_2 state, the number of T_w states specified by bits WC1 and WC0 are inserted between the T_2 and T_3 states when external space is accessed. No additional T_w states are inserted even if the $\overline{\text{WAIT}}$ pin remains low. Pin auto-wait mode can be used for an easy interface to low-speed memory, simply by routing the chip select signal to the $\overline{\text{WAIT}}$ pin.

Figure 6.7 shows an example of wait state insertion timing.

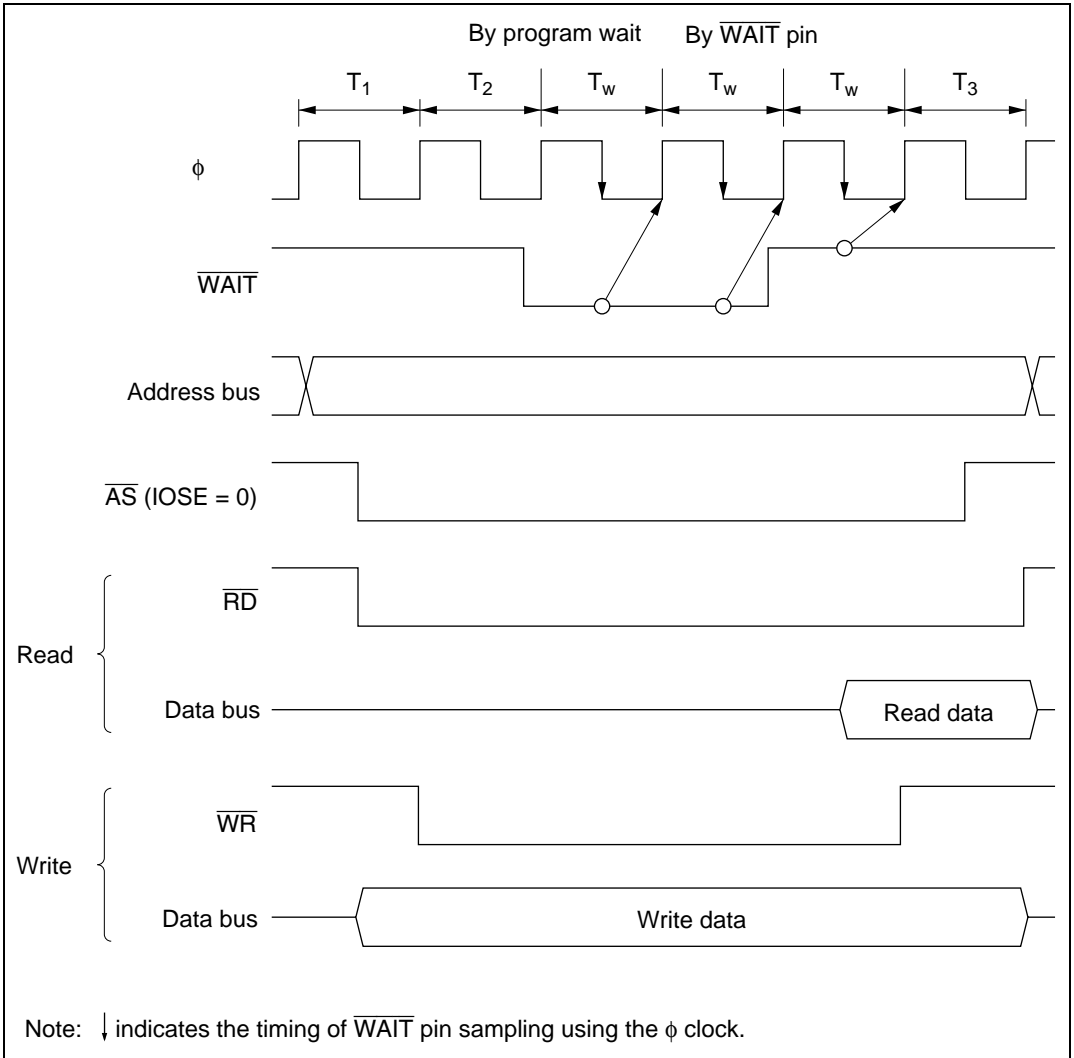


Figure 6.7 Example of Wait State Insertion Timing

The settings after a reset are: 3-state access, insertion of 3 program wait states, and $\overline{\text{WAIT}}$ input disabled.

6.5 Burst ROM Interface

6.5.1 Overview

With the H8S/2138 Group and H8S/2134 Group, external space area 0 can be designated as burst ROM space, and burst ROM interfacing can be performed.

External space can be designated as burst ROM space by means of the BRSTRM bit in BCR. Consecutive burst accesses of a maximum of 4 words or 8 words can be performed for CPU instruction fetches only. One or two states can be selected for burst access.

6.5.2 Basic Timing

The number of states in the initial cycle (full access) of the burst ROM interface is in accordance with the setting of the AST bit. Also, when the AST bit is set to 1, wait state insertion is possible. One or two states can be selected for the burst cycle, according to the setting of the BRSTS1 bit in BCR. Wait states cannot be inserted.

When the BRSTS0 bit in BCR is cleared to 0, burst access of up to 4 words is performed; when the BRSTS0 bit is set to 1, burst access of up to 8 words is performed.

The basic access timing for burst ROM space is shown in figures 6.8 (a) and (b). The timing shown in figure 6.8 (a) is for the case where the AST and BRSTS1 bits are both set to 1, and that in figure 6.8 (b) is for the case where both these bits are cleared to 0.

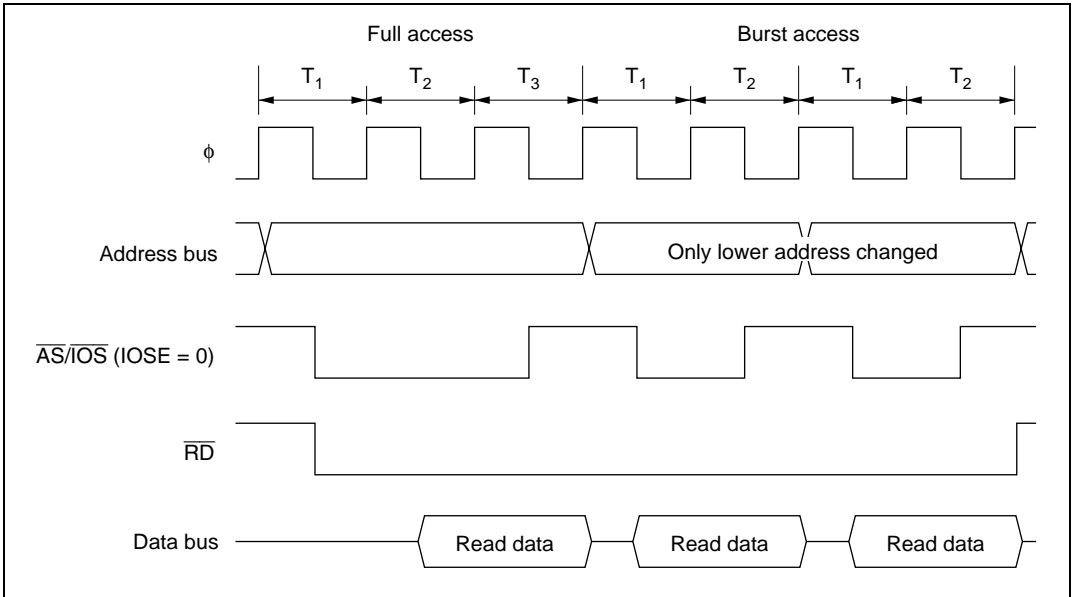


Figure 6.8 (a) Example of Burst ROM Access Timing (When $AST = BRSTS1 = 1$)

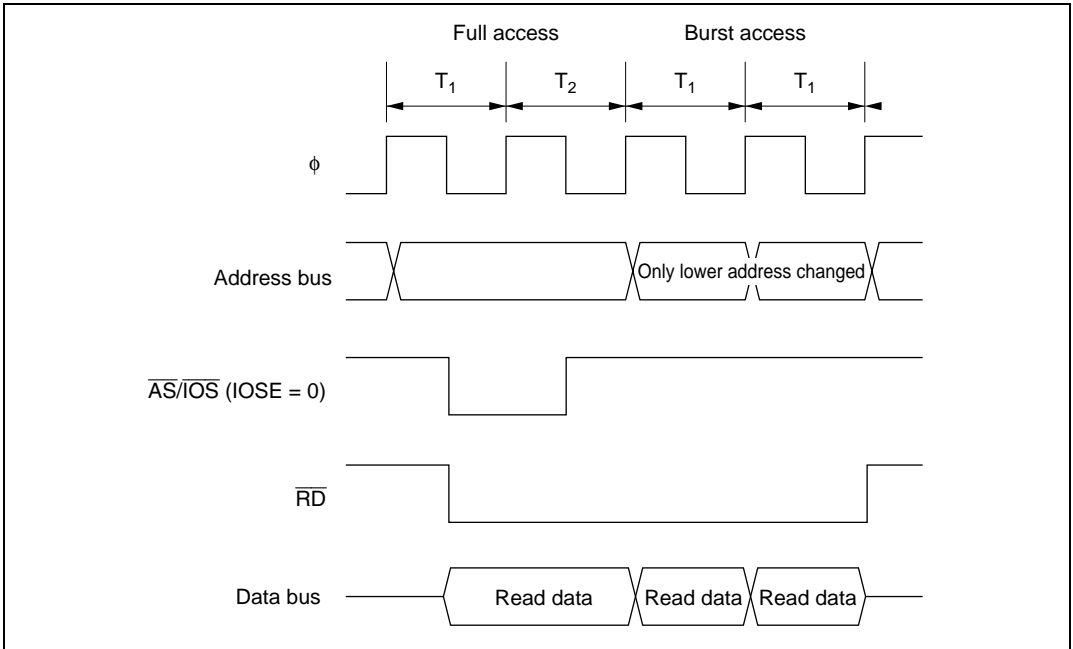


Figure 6.8 (b) Example of Burst ROM Access Timing (When $AST = BRSTS1 = 0$)

6.5.3 Wait Control

As with the basic bus interface, either program wait insertion or pin wait insertion using the $\overline{\text{WAIT}}$ pin can be used in the initial cycle (full access) of the burst ROM interface. See section 6.4.5, Wait Control.

Wait states cannot be inserted in a burst cycle.

6.6 Idle Cycle

6.6.1 Operation

When the H8S/2138 Group or H8S/2134 Group chip accesses external space, it can insert a 1-state idle cycle (T_1) between bus cycles when a write cycle occurs immediately after a read cycle. By inserting an idle cycle it is possible, for example, to avoid data collisions between ROM, with a long output floating time, and high-speed memory, I/O interfaces, and so on.

If an external write occurs after an external read while the ICIS0 bit in BCR is set to 1, an idle cycle is inserted at the start of the write cycle. This is enabled in advanced mode and normal mode.

Figure 6.9 shows an example of the operation in this case. In this example, bus cycle A is a read cycle from ROM with a long output floating time, and bus cycle B is a CPU write cycle. In (a), an idle cycle is not inserted, and a collision occurs in cycle B between the read data from ROM and the CPU write data. In (b), an idle cycle is inserted, and a data collision is prevented.

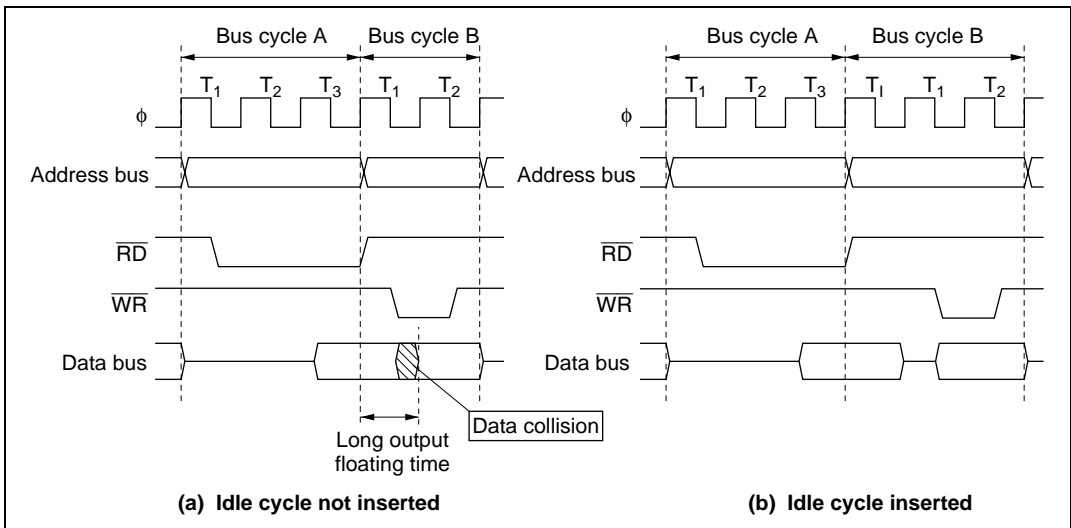


Figure 6.9 Example of Idle Cycle Operation

6.6.2 Pin States in Idle Cycle

Table 6.6 shows pin states in an idle cycle.

Table 6.6 Pin States in Idle Cycle

| Pins | Pin State |
|------------------------------------|----------------------------|
| A15 to A0, $\overline{\text{IOS}}$ | Contents of next bus cycle |
| D7 to D0 | High impedance |
| $\overline{\text{AS}}$ | High |
| $\overline{\text{RD}}$ | High |
| $\overline{\text{WR}}$ | High |

6.7 Bus Arbitration

6.7.1 Overview

The H8S/2138 Group and H8S/2134 Group have a bus arbiter that arbitrates bus master operations.

There are two bus masters, the CPU and the DTC, which perform read/write operations when they have possession of the bus. Each bus master requests the bus by means of a bus request signal. The bus arbiter determines priorities at the prescribed timing, and permits use of the bus by means of a bus request acknowledge signal. The selected bus master then takes possession of the bus and begins its operation.

6.7.2 Operation

The bus arbiter detects the bus masters' bus request signals, and if the bus is requested, sends a bus request acknowledge signal to the bus master making the request. If there are bus requests from both bus masters, the bus request acknowledge signal is sent to the one with the higher priority. When a bus master receives the bus request acknowledge signal, it takes possession of the bus until that signal is canceled.

The order of priority of the bus masters is as follows:

(High) DTC > CPU (Low)

6.7.3 Bus Transfer Timing

Even if a bus request is received from a bus master with a higher priority than that of the bus master that has acquired the bus and is currently operating, the bus is not necessarily transferred immediately. There are specific times at which each bus master can relinquish the bus.

CPU: The CPU is the lowest-priority bus master, and if a bus request is received from the DTC, the bus arbiter transfers the bus to the DTC. The timing for transfer of the bus is as follows:

- The bus is transferred at a break between bus cycles. However, if a bus cycle is executed in discrete operations, as in the case of a longword-size access, the bus is not transferred between the operations.
See appendix A.5, Bus States during Instruction Execution, for timings at which the bus is not transferred.
- If the CPU is in sleep mode, it transfers the bus immediately.

DTC: The DTC sends the bus arbiter a request for the bus when an activation request is generated.

The DTC does not release the bus until it has completed a group of processing operations.

Section 7 Data Transfer Controller [H8S/2138 Group]

Provided in the H8S/2138 Group; not provided in the H8S/2134 Group.

7.1 Overview

The H8S/2138 Group includes a data transfer controller (DTC). The DTC can be activated by an interrupt or software, to transfer data.

7.1.1 Features

- Transfer possible over any number of channels
 - Transfer information is stored in memory
 - One activation source can trigger a number of data transfers (chain transfer)
- Wide range of transfer modes
 - Normal, repeat, and block transfer modes available
 - Incrementing, decrementing, and fixing of transfer source and destination addresses can be selected
- Direct specification of 16-Mbyte address space possible
 - 24-bit transfer source and destination addresses can be specified
- Transfer can be set in byte or word units
- A CPU interrupt can be requested for the interrupt that activated the DTC
 - An interrupt request can be issued to the CPU after one data transfer ends
 - An interrupt request can be issued to the CPU after all specified data transfers have ended
- Activation by software is possible
- Module stop mode can be set
 - The initial setting enables DTC registers to be accessed. DTC operation is halted by setting module stop mode

7.1.2 Block Diagram

Figure 7.1 shows a block diagram of the DTC.

The DTC's register information is stored in the on-chip RAM*. A 32-bit bus connects the DTC to the on-chip RAM (1 kbyte), enabling 32-bit/1-state reading and writing of the DTC register information.

Note: * When the DTC is used, the RAME bit in SYSCR must be set to 1.

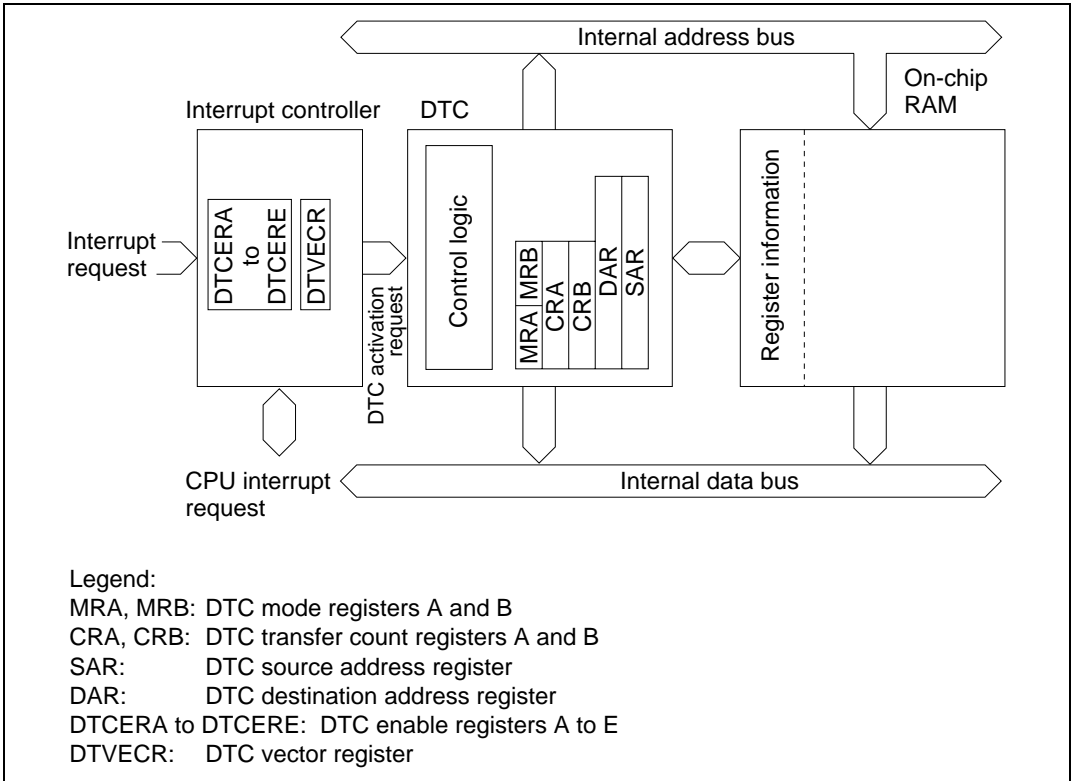


Figure 7.1 Block Diagram of DTC

7.1.3 Register Configuration

Table 7.1 summarizes the DTC registers.

Table 7.1 DTC Registers

| Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|----------------------------------|----------------------|-----------------|---------------|-----------------------|
| DTC mode register A | MRA | — ^{*2} | Undefined | — ^{*3} |
| DTC mode register B | MRB | — ^{*2} | Undefined | — ^{*3} |
| DTC source address register | SAR | — ^{*2} | Undefined | — ^{*3} |
| DTC destination address register | DAR | — ^{*2} | Undefined | — ^{*3} |
| DTC transfer count register A | CRA | — ^{*2} | Undefined | — ^{*3} |
| DTC transfer count register B | CRB | — ^{*2} | Undefined | — ^{*3} |
| DTC enable registers | DTCER ^{*4} | R/W | H'00 | H'FEEE to H'FEF2 |
| DTC vector register | DTVECR ^{*4} | R/W | H'00 | H'FEF3 |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | MSTPCRL | R/W | H'FF | H'FF87 |

Notes: 1. Lower 16 bits of the address.

2. Registers within the DTC cannot be read or written to directly.

3. Addresses H'EC00 to H'EFFF contain register information. They cannot be located in external memory space.

When the DTC is used, do not clear the RAME bit in SYSCR to 0.

4. The H8S/2134 Group does not include an on-chip DTC, and therefore the DTCER and DTVECR register addresses should not be accessed by the CPU.

7.2 Register Descriptions

7.2.1 DTC Mode Register A (MRA)

| | | | | | | | | |
|---------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SM1 | SM0 | DM1 | DM0 | MD1 | MD0 | DTS | Sz |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/Write | — | — | — | — | — | — | — | — |

MRA is an 8-bit register that controls the DTC operating mode.

Bits 7 and 6—Source Address Mode 1 and 0 (SM1, SM0): These bits specify whether SAR is to be incremented, decremented, or left fixed after a data transfer.

| Bit 7 | Bit 6 | Description |
|-------|-------|---|
| SM1 | SM0 | Description |
| 0 | — | SAR is fixed |
| 1 | 0 | SAR is incremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |
| | 1 | SAR is decremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |

Bits 5 and 4—Destination Address Mode 1 and 0 (DM1, DM0): These bits specify whether DAR is to be incremented, decremented, or left fixed after a data transfer.

| Bit 5 | Bit 4 | Description |
|-------|-------|---|
| DM1 | DM0 | Description |
| 0 | — | DAR is fixed |
| 1 | 0 | DAR is incremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |
| | 1 | DAR is decremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |

Bits 3 and 2—DTC Mode (MD1, MD0): These bits specify the DTC transfer mode.

| Bit 3 | Bit 2 | |
|-------|-------|---------------------|
| MD1 | MD0 | Description |
| 0 | 0 | Normal mode |
| | 1 | Repeat mode |
| 1 | 0 | Block transfer mode |
| | 1 | — |

Bit 1—DTC Transfer Mode Select (DTS): Specifies whether the source side or the destination side is set to be a repeat area or block area, in repeat mode or block transfer mode.

| Bit 1 | |
|-------|---|
| DTS | Description |
| 0 | Destination side is repeat area or block area |
| 1 | Source side is repeat area or block area |

Bit 0—DTC Data Transfer Size (Sz): Specifies the size of data to be transferred.

| Bit 0 | |
|-------|--------------------|
| Sz | Description |
| 0 | Byte-size transfer |
| 1 | Word-size transfer |

7.2.2 DTC Mode Register B (MRB)

| | | | | | | | | |
|---------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | CHNE | DISEL | — | — | — | — | — | — |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/Write | — | — | — | — | — | — | — | — |

MRB is an 8-bit register that controls the DTC operating mode.

Bit 7—DTC Chain Transfer Enable (CHNE): Specifies chain transfer. In chain transfer, multiple data transfers can be performed consecutively in response to a single transfer request. With data transfer for which CHNE is set to 1, there is no determination of the end of the specified number of transfers, clearing of the interrupt source flag, or clearing of DTCER.

Bit 7

| CHNE | Description |
|------|---|
| 0 | End of DTC data transfer (activation waiting state is entered) |
| 1 | DTC chain transfer (new register information is read, then data is transferred) |

Bit 6—DTC Interrupt Select (DISEL): Specifies whether interrupt requests to the CPU are disabled or enabled after a data transfer.

Bit 6

| DISEL | Description |
|-------|--|
| 0 | After a data transfer ends, the CPU interrupt is disabled unless the transfer counter is 0 (the DTC clears the interrupt source flag of the activating interrupt to 0) |
| 1 | After a data transfer ends, the CPU interrupt is enabled (the DTC does not clear the interrupt source flag of the activating interrupt to 0) |

Bits 5 to 0—Reserved: In the H8S/2138 Group these bits have no effect on DTC operation, and should always be written with 0.

7.2.3 DTC Source Address Register (SAR)

| | | | | | | | | | | | |
|---------------|----------------|----------------|----------------|----------------|----------------|-----|----------------|----------------|----------------|----------------|----------------|
| Bit | 23 | 22 | 21 | 20 | 19 | --- | 4 | 3 | 2 | 1 | 0 |
| | | | | | | --- | | | | | |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | --- | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/write | — | — | — | — | — | --- | — | — | — | — | — |

SAR is a 24-bit register that designates the source address of data to be transferred by the DTC. For word-size transfer, specify an even source address.

7.2.4 DTC Destination Address Register (DAR)

| | | | | | | | | | | | |
|---------------|----------------|----------------|----------------|----------------|----------------|-----|----------------|----------------|----------------|----------------|----------------|
| Bit | 23 | 22 | 21 | 20 | 19 | --- | 4 | 3 | 2 | 1 | 0 |
| | | | | | | --- | | | | | |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | --- | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/write | — | — | — | — | — | --- | — | — | — | — | — |

DAR is a 24-bit register that designates the destination address of data to be transferred by the DTC. For word-size transfer, specify an even destination address.

7.2.5 DTC Transfer Count Register A (CRA)

| | | | | | | | | | | | | | | | | |
|---------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/Write | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — |

CRA is a 16-bit register that designates the number of times data is to be transferred by the DTC.

In normal mode, the entire CRA register functions as a 16-bit transfer counter (1 to 65,536). It is decremented by 1 every time data is transferred, and transfer ends when the count reaches H'0000.

In repeat mode or block transfer mode, CRA is divided into two parts: the upper 8 bits (CRAH) and the lower 8 bits (CRAL). CRAH holds the number of transfers while CRAL functions as an 8-bit transfer counter (1 to 256). CRAL is decremented by 1 every time data is transferred, and the contents of CRAH are transferred when the count reaches H'00. This operation is repeated.

7.2.6 DTC Transfer Count Register B (CRB)

| | | | | | | | | | | | | | | | | |
|---------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/Write | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — | — |

CRB is a 16-bit register that designates the number of times data is to be transferred by the DTC in block transfer mode. It functions as a 16-bit transfer counter (1 to 65,536) that is decremented by 1 every time data is transferred, and transfer ends when the count reaches H'0000.

7.2.7 DTC Enable Registers (DTCER)

| | | | | | | | | |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | DTCE7 | DTCE6 | DTCE5 | DTCE4 | DTCE3 | DTCE2 | DTCE1 | DTCE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

The DTC enable registers comprise five 8-bit readable/writable registers, DTCERA to DTCERE, with bits corresponding to the interrupt sources that can activate the DTC. These bits enable or disable DTC service for the corresponding interrupt sources.

The DTC enable registers are initialized to H'00 by a reset and in hardware standby mode.

Bit n—DTC Activation Enable (DTCEn)

Bit n

| DTCEn | Description |
|-------|--|
| 0 | DTC activation by interrupt is disabled (Initial value) [Clearing conditions] <ul style="list-style-type: none"> When data transfer ends with the DISEL bit set to 1 When the specified number of transfers end |
| 1 | DTC activation by interrupt is enabled [Holding condition] When the DISEL bit is 0 and the specified number of transfers have not ended |

(n = 7 to 0)

A DTCE bit can be set for each interrupt source that can activate the DTC. The correspondence between interrupt sources and DTCE bits is shown in table 7.4, together with the vector number generated by the interrupt controller in each case.

For DTCE bit setting, read/write operations must be performed using bit-manipulation instructions such as BSET and BCLR. For the initial setting only, however, when multiple activation sources are set at one time, it is possible to disable interrupts and write after executing a dummy read on the relevant register.

7.2.8 DTC Vector Register (DTVECR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | SWDTE | DTVEC6 | DTVEC5 | DTVEC4 | DTVEC3 | DTVEC2 | DTVEC1 | DTVEC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * A value of 1 can always be written to the SWDTE bit, but 0 can only be written after 1 is read.

DTVECR is an 8-bit readable/writable register that enables or disables DTC activation by software, and sets a vector number for the software activation interrupt.

DTVECR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—DTC Software Activation Enable (SWDTE): Specifies enabling or disabling of DTC software activation. To clear the SWDTE bit by software, read SWDTE when set to 1, then write 0 in the bit.

Bit 7

| SWDTE | Description |
|-------|---|
| 0 | DTC software activation is disabled (Initial value) [Clearing condition] When the DISEL bit is 0 and the specified number of transfers have not ended |
| 1 | DTC software activation is enabled [Holding conditions] <ul style="list-style-type: none"> • When data transfer ends with the DISEL bit set to 1 • When the specified number of transfers end • During software-activated data transfer |

Bits 6 to 0—DTC Software Activation Vectors 6 to 0 (DTVEC6 to DTVEC0): These bits specify a vector number for DTC software activation.

The vector address is $H'0400 + (\text{vector number}) \ll 1$ (where $\ll 1$ indicates a 1-bit left shift). For example, if $DTVEC6$ to $DTVEC0 = H'10$, the vector address is $H'0420$.

7.2.9 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control.

When the MSTP14 bit in MSTPCR is set to 1, the DTC operation stops at the end of the bus cycle and a transition is made to module stop mode. Note that 1 cannot be written to the MSTP14 bit when the DTC is being activated. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to $H'3FFF$ by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 6—Module Stop (MSTP14): Specifies the DTC module stop mode.

MSTPCRH

Bit 6

| MSTP14 | Description |
|--------|---|
| 0 | DTC module stop mode is cleared (Initial value) |
| 1 | DTC module stop mode is set |

7.3 Operation

7.3.1 Overview

When activated, the DTC reads register information that is already stored in memory and transfers data on the basis of that register information. After the data transfer, it writes updated register information back to memory. Pre-storage of register information in memory makes it possible to transfer data over any required number of channels. Setting the CHNE bit to 1 makes it possible to perform a number of transfers with a single activation.

Figure 7.2 shows a flowchart of DTC operation.

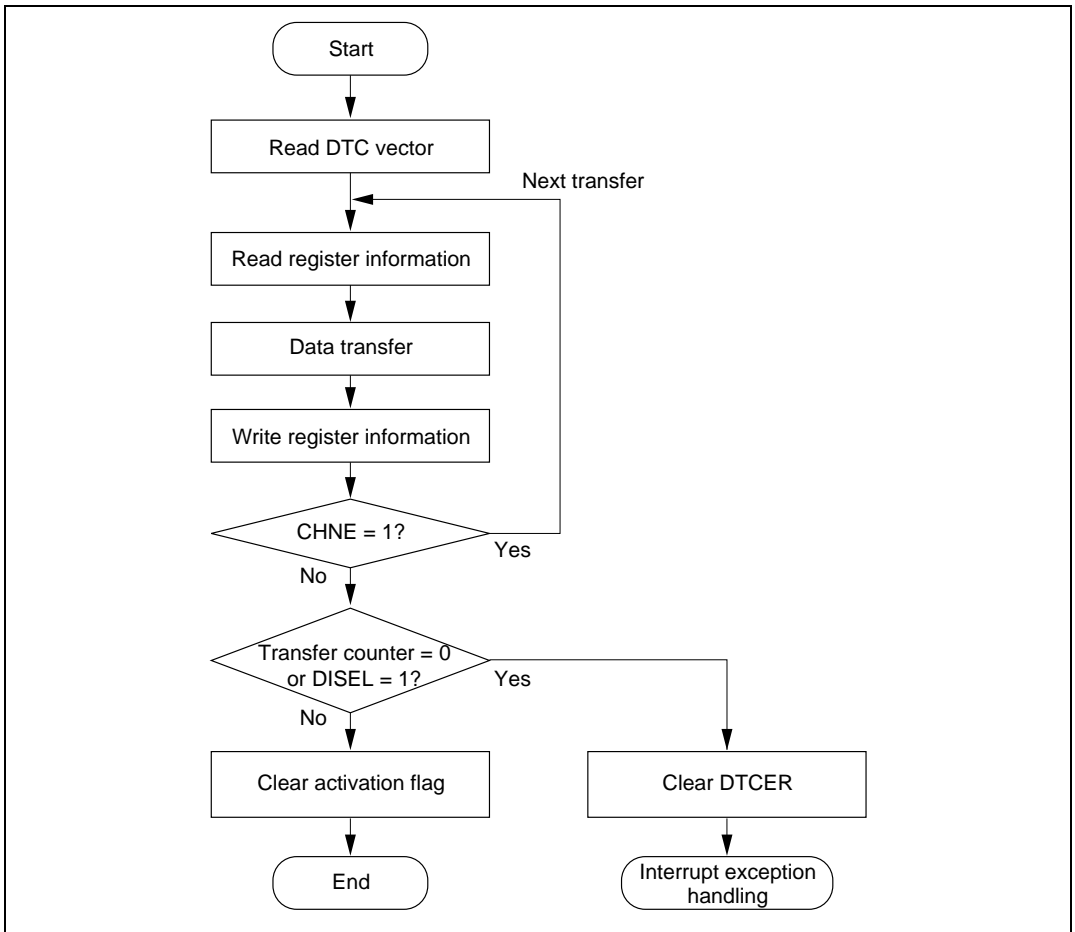


Figure 7.2 Flowchart of DTC Operation

The DTC transfer mode can be normal mode, repeat mode, or block transfer mode.

The 24-bit SAR designates the DTC transfer source address and the 24-bit DAR designates the transfer destination address. After each transfer, SAR and DAR are independently incremented, decremented, or left fixed.

Table 7.2 outlines the functions of the DTC.

Table 7.2 DTC Functions

| Transfer Mode | Activation Source | Address Registers | |
|--|---|-------------------|----------------------|
| | | Transfer Source | Transfer Destination |
| <ul style="list-style-type: none"> • Normal mode <ul style="list-style-type: none"> — One transfer request transfers one byte or one word — Memory addresses are incremented or decremented by 1 or 2 — Up to 65,536 transfers possible • Repeat mode <ul style="list-style-type: none"> — One transfer request transfers one byte or one word — Memory addresses are incremented or decremented by 1 or 2 — After the specified number of transfers (1 to 256), the initial state resumes and operation continues • Block transfer mode <ul style="list-style-type: none"> — One transfer request transfers a block of the specified size — Block size is from 1 to 256 bytes or words — Up to 65,536 transfers possible — A block area can be designated at either the source or destination | <ul style="list-style-type: none"> • IRQ • FRT ICI or OCI • 8-bit timer CMI • Host interface IBF • SCI TXI or RXI • A/D converter ADI • IIC IICI • Software | 24 bits | 24 bits |

7.3.2 Activation Sources

The DTC operates when activated by an interrupt or by a write to DTVECR by software (software activation). An interrupt request can be directed to the CPU or DTC, as designated by the corresponding DTCER bit. The interrupt request is directed to the DTC when the corresponding bit is set to 1, and to the CPU when the bit is cleared to 0.

At the end of one data transfer (or the last of the consecutive transfers in the case of chain transfer) the interrupt source or the corresponding DTCER bit is cleared. Table 7.3 shows activation sources and DTCER clearing.

The interrupt source flag for RXI0, for example, is the RDRF flag in SCI0.

Table 7.3 Activation Sources and DTCER Clearing

| Activation Source | When DISEL Bit Is 0 and Specified Number of Transfers Have Not Ended | When DISEL Bit Is 1 or Specified Number of Transfers Have Ended |
|--------------------------|--|---|
| Software activation | SWDTE bit cleared to 0 | <ul style="list-style-type: none"> • SWDTE bit held at 1 • Interrupt request sent to CPU |
| Interrupt activation | <ul style="list-style-type: none"> • Corresponding DTCER bit held at 1 • Activation source flag cleared to 0 | <ul style="list-style-type: none"> • Corresponding DTCER bit cleared to 0 • Activation source flag held at 1 • Activation source interrupt request sent to CPU |

Figure 7.3 shows a block diagram of activation source control. For details see section 5, Interrupt Controller.

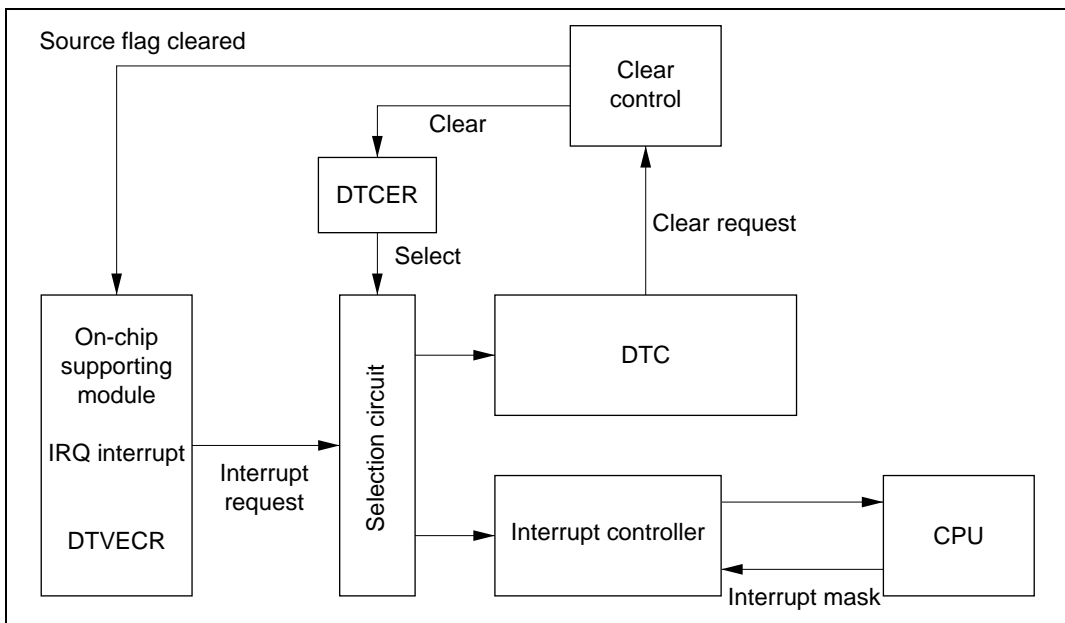


Figure 7.3 Block Diagram of DTC Activation Source Control

When an interrupt has been designated a DTC activation source, existing CPU mask level and interrupt controller priorities have no effect. If there is more than one activation source at the same time, the DTC is activated in accordance with the default priorities.

7.3.3 DTC Vector Table

Figure 7.4 shows the correspondence between DTC vector addresses and register information.

Table 7.4 shows the correspondence between activation sources, vector addresses, and DTCER bits. When the DTC is activated by software, the vector address is obtained from: $H'0400 + DTVECR[6:0] \ll 1$ (where $\ll 1$ indicates a 1-bit left shift). For example, if DTVECR is H'10, the vector address is H'0420.

The DTC reads the start address of the register information from the vector address set for each activation source, and then reads the register information from that start address. The register information can be placed at predetermined addresses in the on-chip RAM. The start address of the register information should be an integral multiple of four.

The configuration of the vector address is the same in both normal and advanced modes, a 2-byte unit being used in both cases. These two bytes specify the lower bits of the address in the on-chip RAM.

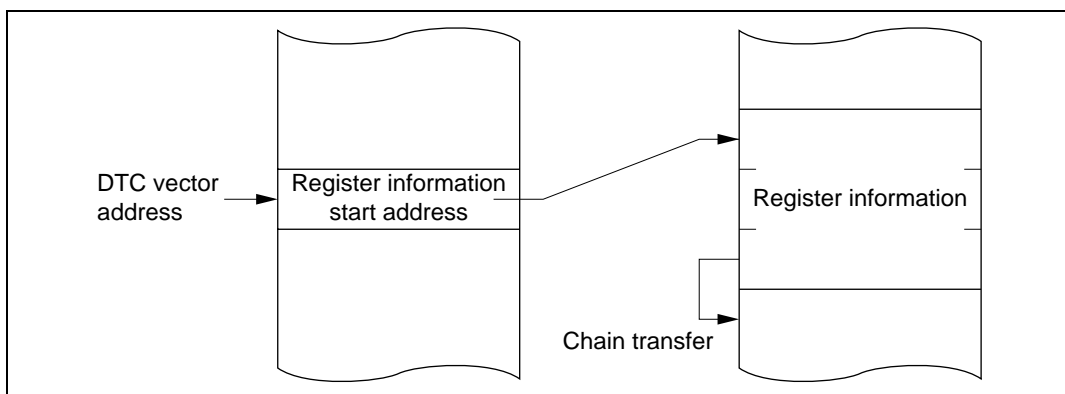


Figure 7.4 Correspondence between DTC Vector Address and Register Information

Table 7.4 Interrupt Sources, DTC Vector Addresses, and Corresponding DTCEs

| Interrupt Source | Origin of Interrupt Source | Vector Number | Vector Address | DTCE* | Priority |
|--|----------------------------|--------------------------------|----------------------------------|--------|----------|
| Write to DTVECR | Software | DTVECR (Decimal indication) | H'0400 + DTVECR [6:0] << 1 | — | High |
| IRQ0 | External pin | 16 | H'0420 | DTCEA7 | ↑ |
| IRQ1 | | 17 | H'0422 | DTCEA6 | |
| IRQ2 | | 18 | H'0424 | DTCEA5 | |
| IRQ3 | | 19 | H'0426 | DTCEA4 | |
| ADI (A/D conversion end) | A/D | 28 | H'0438 | DTCEA3 | |
| ICIA (FRT input capture A) | FRT | 48 | H'0460 | DTCEA2 | |
| ICIB (FRT input capture B) | | 49 | H'0462 | DTCEA1 | |
| OCIA (FRT output compare A) | | 52 | H'0468 | DTCEA0 | |
| OCIB (FRT output compare B) | | 54 | H'046A | DTCEB7 | |
| CMIA0 (TMR0 compare-match A) | TMR0 | 64 | H'0480 | DTCEB2 | |
| CMIB0 (TMR0 compare-match B) | | 65 | H'0482 | DTCEB1 | |
| CMIA1 (TMR1 compare-match A) | TMR1 | 68 | H'0488 | DTCEB0 | |
| CMIB1 (TMR1 compare-match B) | | 69 | H'048A | DTCEC7 | |
| CMIA Y (TMR Y compare-match A) | TMR Y | 72 | H'0490 | DTCEC6 | |
| CMIB Y (TMR Y compare-match B) | | 73 | H'0492 | DTCEC5 | |
| IBF1 (IDR1 reception completed) | HIF | 76 | H'0498 | DTCEC4 | |
| IBF2 (IDR2 reception completed) | | 77 | H'049A | DTCEC3 | |
| RX10 (reception completed 0) | SCI channel 0 | 81 | H'04A2 | DTCEC2 | |
| TX10 (transmit data empty 0) | | 82 | H'04A4 | DTCEC1 | |
| RX11 (reception completed 1) | SCI channel 1 | 85 | H'04AA | DTCEC0 | |
| TX11 (transmit data empty 1) | | 86 | H'04AC | DTCED7 | |
| RX12 (reception completed 2) | SCI channel 2 | 89 | H'04B2 | DTCED6 | |
| TX12 (transmit data empty 2) | | 90 | H'04B4 | DTCED5 | |
| IIC10 (IIC0 1-byte transmission/ reception completed) | IIC0 (option) | 92 | H'04B8 | DTCED4 | |
| IIC11 (IIC1 1-byte transmission/ reception completed) | IIC1 (option) | 94 | H'04BC | DTCED3 | |
| | | | | | Low |

Note: * DTCE bits with no corresponding interrupt are reserved, and should be written with 0.

7.3.4 Location of Register Information in Address Space

Figure 7.5 shows how the register information should be located in the address space.

Locate the MRA, SAR, MRB, DAR, CRA, and CRB registers, in that order, from the start address of the register information (vector address contents). In chain transfer, locate the register information in consecutive areas.

Locate the register information in the on-chip RAM (addresses: H'FFEC00 to H'FFEF00).

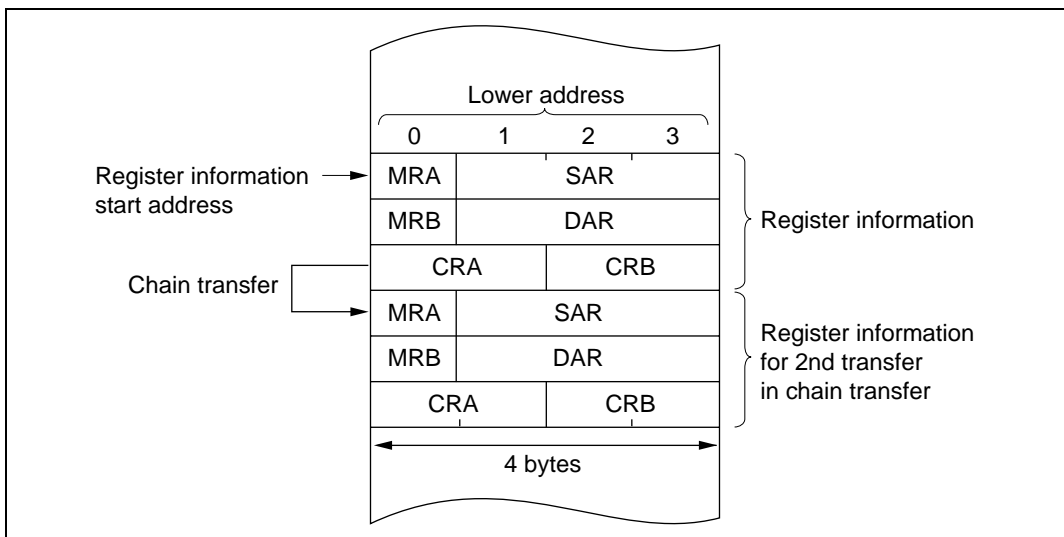


Figure 7.5 Location of DTC Register Information in Address Space

7.3.5 Normal Mode

In normal mode, one operation transfers one byte or one word of data.

From 1 to 65,536 transfers can be specified. Once the specified number of transfers have ended, a CPU interrupt can be requested.

Table 7.5 lists the register information in normal mode and figure 7.6 shows memory mapping in normal mode.

Table 7.5 Register Information in Normal Mode

| Name | Abbreviation | Function |
|----------------------------------|--------------|------------------------------|
| DTC source address register | SAR | Transfer source address |
| DTC destination address register | DAR | Transfer destination address |
| DTC transfer count register A | CRA | Transfer count |
| DTC transfer count register B | CRB | Not used |

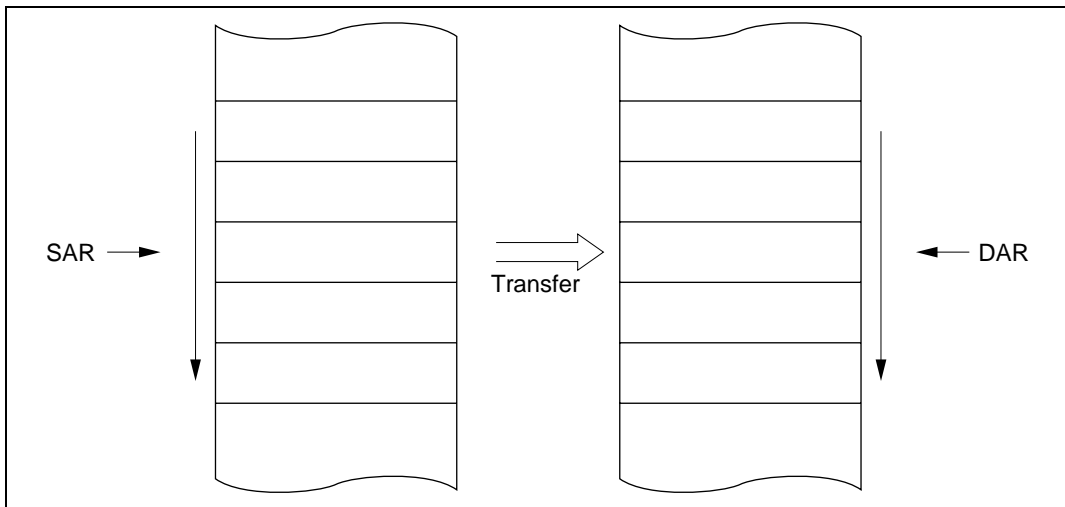


Figure 7.6 Memory Mapping in Normal Mode

7.3.6 Repeat Mode

In repeat mode, one operation transfers one byte or one word of data.

From 1 to 256 transfers can be specified. Once the specified number of transfers have ended, the initial address register state specified by the transfer counter and repeat area resumes and transfer is repeated. In repeat mode the transfer counter does not reach H'00, and therefore CPU interrupts cannot be requested when DISEL = 0.

Table 7.6 lists the register information in repeat mode and figure 7.7 shows memory mapping in repeat mode.

Table 7.6 Register Information in Repeat Mode

| Name | Abbreviation | Function |
|----------------------------------|--------------|------------------------------|
| DTC source address register | SAR | Transfer source address |
| DTC destination address register | DAR | Transfer destination address |
| DTC transfer count register AH | CRAH | Holds number of transfers |
| DTC transfer count register AL | CRAL | Transfer count |
| DTC transfer count register B | CRB | Not used |

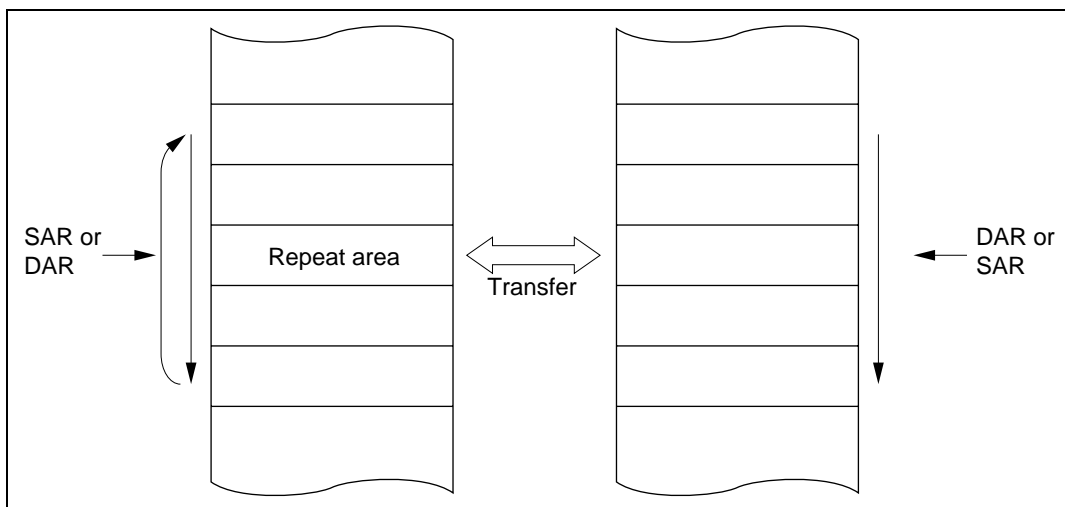


Figure 7.7 Memory Mapping in Repeat Mode

7.3.7 Block Transfer Mode

In block transfer mode, one operation transfers one block of data. Either the transfer source or the transfer destination is specified as a block area.

The block size is 1 to 256. When the transfer of one block ends, the initial state of the block size counter and the address register specified in the block area is restored. The other address register is successively incremented or decremented, or left fixed.

From 1 to 65,536 transfers can be specified. Once the specified number of transfers have ended, a CPU interrupt is requested.

Table 7.7 lists the register information in block transfer mode and figure 7.8 shows memory mapping in block transfer mode.

Table 7.7 Register Information in Block Transfer Mode

| Name | Abbreviation | Function |
|----------------------------------|---------------------|------------------------------|
| DTC source address register | SAR | Transfer source address |
| DTC destination address register | DAR | Transfer destination address |
| DTC transfer count register AH | CRAH | Holds block size |
| DTC transfer count register AL | CRAL | Block size count |
| DTC transfer count register B | CRB | Transfer counter |

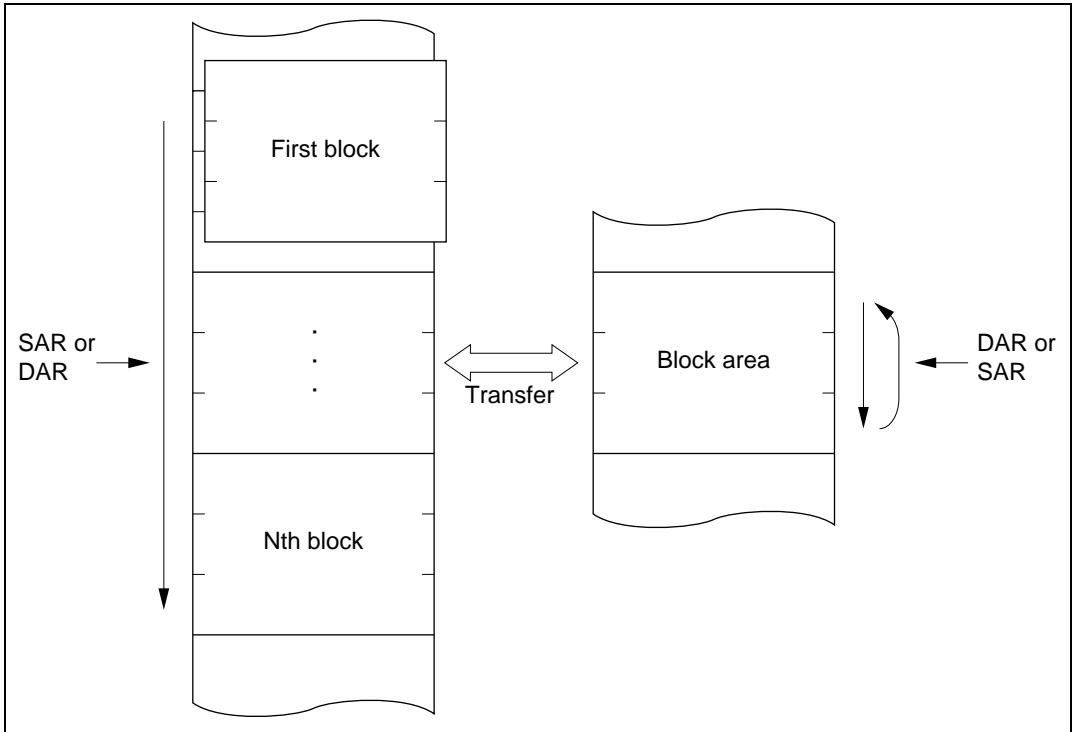


Figure 7.8 Memory Mapping in Block Transfer Mode

7.3.8 Chain Transfer

Setting the CHNE bit to 1 enables a number of data transfers to be performed consecutively in response to a single transfer request. SAR, DAR, CRA, CRB, MRA, and MRB, which define data transfers, can be set independently.

Figure 7.9 shows memory mapping for chain transfer.

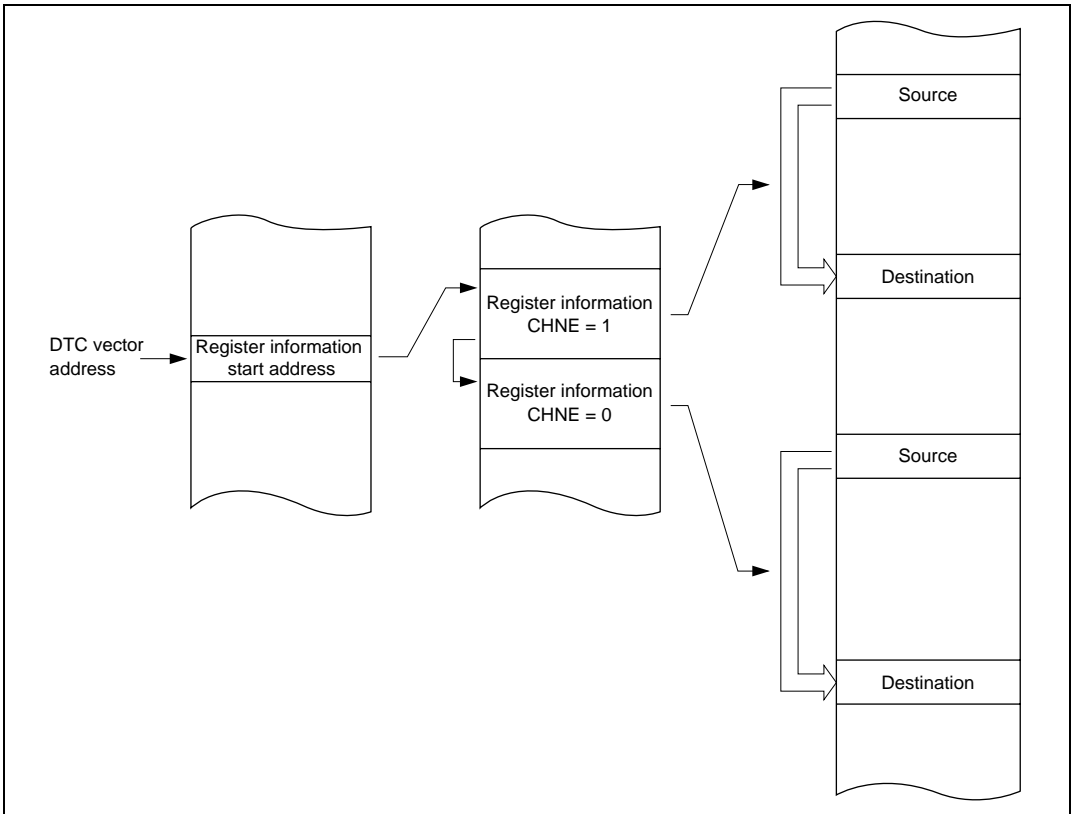


Figure 7.9 Memory Mapping in Chain Transfer

In the case of transfer with CHNE set to 1, an interrupt request to the CPU is not generated at the end of the specified number of transfers or by setting of the DISEL bit to 1, and the interrupt source flag for the activation source is not affected.

7.3.9 Operation Timing

Figures 7.10 to 7.12 show examples of DTC operation timing.

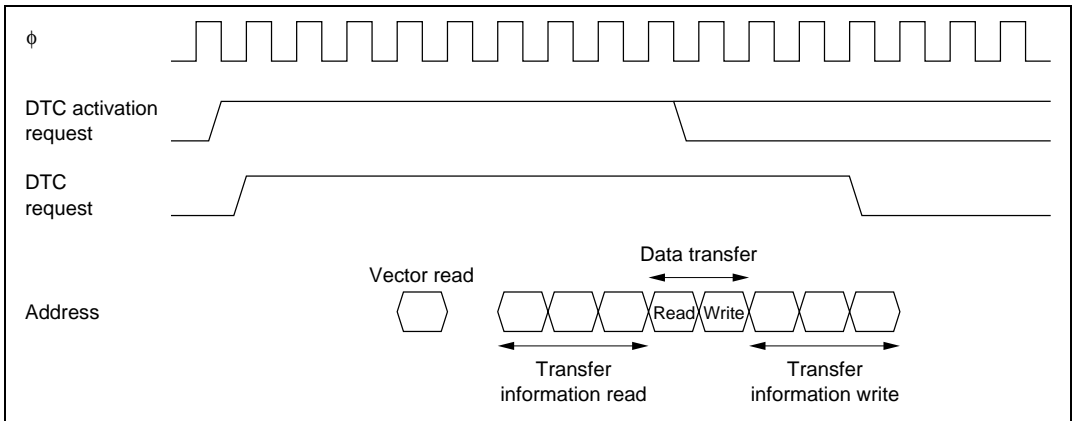


Figure 7.10 DTC Operation Timing (Normal Mode or Repeat Mode)

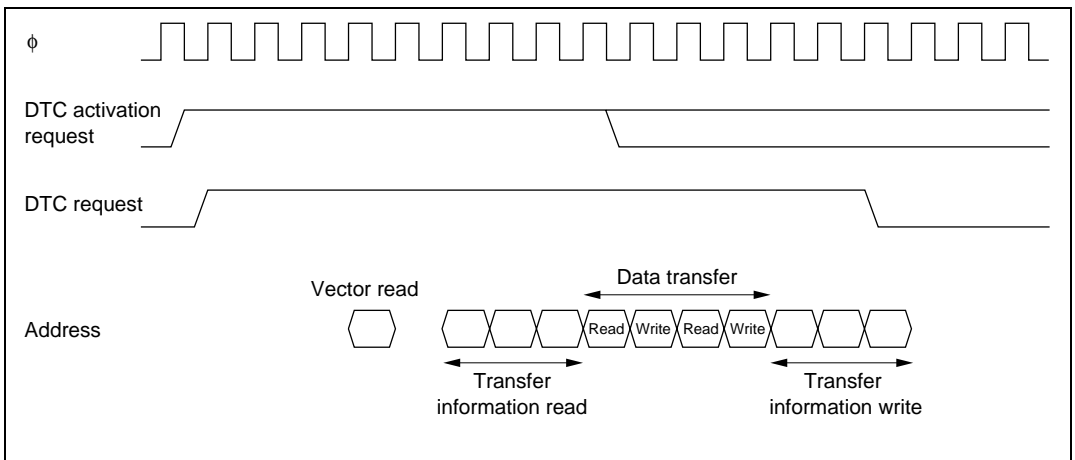


Figure 7.11 DTC Operation Timing (Block Transfer Mode, with Block Size of 2)

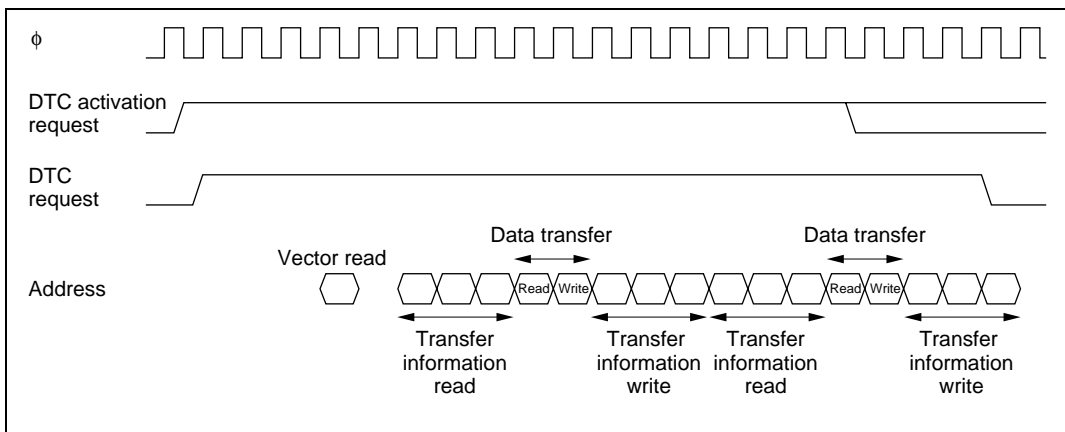


Figure 7.12 DTC Operation Timing (Chain Transfer)

7.3.10 Number of DTC Execution States

Table 7.8 lists execution phases for a single DTC data transfer, and table 7.9 shows the number of states required for each execution phase.

Table 7.8 DTC Execution Phases

| Mode | Vector Read | Register Information | | | Internal |
|----------------|-------------|----------------------|-----------|------------|-----------|
| | I | Read/Write | Data Read | Data Write | Operation |
| | | J | K | L | M |
| Normal | 1 | 6 | 1 | 1 | 3 |
| Repeat | 1 | 6 | 1 | 1 | 3 |
| Block transfer | 1 | 6 | N | N | 3 |

N: Block size (initial setting of CRAH and CRAL)

Table 7.9 Number of States Required for Each Execution Phase

| Object of Access | | | On-Chip RAM | On-Chip ROM | Internal I/O Registers | | External Devices | |
|--------------------|---------------------------------------|-------|----------------|----------------|---------------------------|----|------------------|------|
| Bus width | | | 32 | 16 | 8 | 16 | 8 | 8 |
| Access states | | | 1 | 1 | 2 | 2 | 2 | 3 |
| Execution phase | Vector read | S_I | — | 1 | — | — | 4 | 6+2m |
| | Register information read/write | S_J | 1 | — | — | — | — | — |
| | Byte data read | S_K | 1 | 1 | 2 | 2 | 2 | 3+m |
| | Word data read | S_K | 1 | 1 | 4 | 2 | 4 | 6+2m |
| | Byte data write | S_L | 1 | 1 | 2 | 2 | 2 | 3+m |
| | Word data write | S_L | 1 | 1 | 4 | 2 | 4 | 6+2m |
| Internal operation | | S_M | 1 | 1 | 1 | 1 | 1 | 1 |

The number of execution states is calculated from the formula below. Note that Σ means the sum of all transfers activated by one activation event (the number for which the CHNE bit is set to one, plus 1).

$$\text{Number of execution states} = I \cdot S_I + \Sigma (J \cdot S_J + K \cdot S_K + L \cdot S_L) + M \cdot S_M$$

For example, when the DTC vector address table is located in on-chip ROM, normal mode is set, and data is transferred from the on-chip ROM to an internal I/O register, the time required for the DTC operation is 13 states. The time from activation to the end of the data write is 10 states.

7.3.11 Procedures for Using the DTC

Activation by Interrupt: The procedure for using the DTC with interrupt activation is as follows:

1. Set the MRA, MRB, SAR, DAR, CRA, and CRB register information in the on-chip RAM.
2. Set the start address of the register information in the DTC vector address.
3. Set the corresponding bit in DTCER to 1.
4. Set the enable bits for the interrupt sources to be used as the activation sources to 1. The DTC is activated when an interrupt used as an activation source is generated.
5. After the end of one data transfer, or after the specified number of data transfers have ended, the DTCE bit is cleared to 0 and a CPU interrupt is requested. If the DTC is to continue transferring data, set the DTCE bit to 1.

Activation by Software: The procedure for using the DTC with software activation is as follows:

1. Set the MRA, MRB, SAR, DAR, CRA, and CRB register information in the on-chip RAM.
2. Set the start address of the register information in the DTC vector address.
3. Check that the SWDTE bit is 0.
4. Write 1 in the SWDTE bit and the vector number to DTVECR.
5. Check the vector number written to DTVECR.
6. After the end of one data transfer, if the DISEL bit is 0 and a CPU interrupt is not requested, the SWDTE bit is cleared to 0. If the DTC is to continue transferring data, set the SWDTE bit to 1. When the DISEL bit is 1, or after the specified number of data transfers have ended, the SWDTE bit is held at 1 and a CPU interrupt is requested.

7.3.12 Examples of Use of the DTC

Normal Mode: An example is shown in which the DTC is used to receive 128 bytes of data via the SCI.

1. Set MRA to fixed source address ($SM1 = SM0 = 0$), incrementing destination address ($DM1 = 1$, $DM0 = 0$), normal mode ($MD1 = MD0 = 0$), and byte size ($Sz = 0$). The DTS bit can have any value. Set MRB for one data transfer by one interrupt ($CHNE = 0$, $DISEL = 0$). Set the SCI RDR address in SAR, the start address of the RAM area where the data will be received in DAR, and 128 (H'0080) in CRA. CRB can be set to any value.
2. Set the start address of the register information at the DTC vector address.
3. Set the corresponding bit in DTCER to 1.
4. Set the SCI to the appropriate receive mode. Set the RIE bit in SCR to 1 to enable the reception complete (RXI) interrupt. Since the generation of a receive error during the SCI reception operation will disable subsequent reception, the CPU should be enabled to accept receive error interrupts.
5. Each time reception of one byte of data ends on the SCI, the RDRF flag in SSR is set to 1, an RXI interrupt is generated, and the DTC is activated. The receive data is transferred from RDR to RAM by the DTC. DAR is incremented and CRA is decremented. The RDRF flag is automatically cleared to 0.
6. When CRA becomes 0 after the 128 data transfers have ended, the RDRF flag is held at 1, the DTCE bit is cleared to 0, and an RXI interrupt request is sent to the CPU. The interrupt handling routine should perform wrap-up processing.

Software Activation: An example is shown in which the DTC is used to transfer a block of 128 bytes of data by means of software activation. The transfer source address is H'1000 and the destination address is H'2000. The vector number is H'60, so the vector address is H'04C0.

1. Set MRA to incrementing source address (SM1 = 1, SM0 = 0), incrementing destination address (DM1 = 1, DM0 = 0), block transfer mode (MD1 = 1, MD0 = 0), and byte size (Sz = 0). The DTS bit can have any value. Set MRB for one block transfer by one interrupt (CHNE = 0). Set the transfer source address (H'1000) in SAR, the destination address (H'2000) in DAR, and 128 (H'8080) in CRA. Set 1 (H'0001) in CRB.
2. Set the start address of the register information at the DTC vector address (H'04C0).
3. Check that the SWDTE bit in DTVECR is 0. Check that there is currently no transfer activated by software.
4. Write 1 to the SWDTE bit and the vector number (H'60) to DTVECR. The write data is H'E0.
5. Read DTVECR again and check that it is set to the vector number (H'60). If it is not, this indicates that the write failed. This is presumably because an interrupt occurred between steps 3 and 4 and led to a different software activation. To activate this transfer, go back to step 3.
6. If the write was successful, the DTC is activated and a block of 128 bytes of data is transferred.
7. After the transfer, an SWDTEND interrupt occurs. The interrupt handling routine should clear the SWDTE bit to 0 and perform other wrap-up processing.

7.4 Interrupts

An interrupt request is issued to the CPU when the DTC finishes the specified number of data transfers, or a data transfer for which the DISEL bit was set to 1. In the case of interrupt activation, the interrupt set as the activation source is generated. These interrupts to the CPU are subject to CPU mask level and interrupt controller priority level control.

In the case of activation by software, a software-activated data transfer end interrupt (SWDTEND) is generated.

When the DISEL bit is 1 and one data transfer has ended, or the specified number of transfers have ended, after data transfer ends, the SWDTE bit is held at 1 and an SWDTEND interrupt is generated. The interrupt handling routine should clear the SWDTE bit to 0.

When the DTC is activated by software, an SWDTEND interrupt is not generated during a data transfer wait or during data transfer even if the SWDTE bit is set to 1.

7.5 Usage Notes

Module Stop: When the MSTP14 bit in MSTPCR is set to 1, the DTC clock stops, and the DTC enters the module stop state. However, 1 cannot be written in the MSTP14 bit while the DTC is operating. When the DTC is placed in the module stop state, the DTCER registers must all be in the cleared state when the MSTP14 bit is set to 1.

On-Chip RAM: The MRA, MRB, SAR, DAR, CRA, and CRB registers are all located in on-chip RAM. When the DTC is used, the RAME bit in SYSCR must not be cleared to 0.

DTCE Bit Setting: For DTCE bit setting, read/write operations must be performed using bit-manipulation instructions such as BSET and BCLR. For the initial setting only, however, when multiple activation sources are set at one time, it is possible to disable interrupts and write after executing a dummy read on the relevant register.

Section 8 I/O Ports

8.1 Overview

The H8S/2138 Group and H8S/2134 Group have eight I/O ports (ports 1 to 6, 8, and 9), and one input-only port (port 7).

Tables 8.1 and 8.2 summarize the port functions. The pins of each port also have other functions.

Each port includes a data direction register (DDR) that controls input/output (not provided for the input-only port) and data registers (DR, ODR) that store output data.

Ports 1 to 3, and 6 have an on-chip MOS input pull-up function. Ports 1 to 3 and 6 have a MOS input pull-up control register (PCR), in addition to DDR and DR, to control the on/off status of the MOS input pull-ups.

Ports 1 to 6, 8, and 9 can drive a single TTL load and 30 pF capacitive load. All the I/O ports can drive a Darlington transistor when in output mode. Ports 1, 2, and 3 can drive an LED (10 mA sink current).

In the H8S/2138 Group, P52 in port 5 and P97 in port 9 are NMOS push-pull outputs.

Note that the H8S/2134 Group has subset specifications that do not include some supporting modules. For differences in pin functions, see table 8.1, H8S/2138 Group Port Functions, and table 8.2, H8S/2134 Group Port Functions.

Table 8.1 H8S/2138 Group Port Functions

| Port | Description | Pins | Expanded Modes | | Single-Chip Mode |
|--------|--|---|----------------------------------|--|--|
| | | | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) |
| Port 1 | <ul style="list-style-type: none"> • 8-bit I/O port • On-chip MOS input pull-ups • LED drive capability | P17 to P10/ A7 to A0/ PW7 to PW0 | Lower address output (A7 to A0) | <p>When DDR = 0 (after reset): input port</p> <p>When DDR = 1: lower address output (A7 to A0) or PWM timer output (PW7 to PW0)</p> | I/O port also functioning as PWM timer output (PW7 to PW0) |
| Port 2 | <ul style="list-style-type: none"> • 8-bit I/O port • On-chip MOS input pull-ups • LED drive capability | P27/A15/PW15/ CBLANK P26/A14/PW14 P25/A13/PW13 P24/A12/PW12 P23/A11/PW11 P22/A10/PW10 P21/A9/PW9 P20/A8/PW8 | Upper address output (A15 to A8) | <p>When DDR = 0 (after reset): input port or timer connection output (CBLANK)</p> <p>When DDR = 1: upper address output (A15 to A8), PWM timer output (PW15 to PW12), timer connection output (CBLANK), or output ports (P27 to P24)</p> | I/O port also functioning as PWM timer output (PW15 to PW8) and timer connection output (CBLANK) |
| Port 3 | <ul style="list-style-type: none"> • 8-bit I/O port • On-chip MOS input pull-ups • LED drive capability | P37 to P30/ HDB7 to HDB0/ D7 to D0 | Data bus input/output (D7 to D0) | | I/O port also functioning as host interface data bus input/output (HDB7 to HDB0) |

| Port | Description | Pins | Expanded Modes | | Single-Chip Mode |
|--------|------------------|---|---|---|------------------------------|
| | | | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) |
| Port 4 | • 8-bit I/O port | P47/PWX1 P46/PWX0 P45/TMRI1/ HIRQ12/CSYNCl P44/TMO1/ HIRQ1/HSYNCO P43/TMCI1/ HIRQ11/HSYNCl P42/TMRI0/SCK2/ SDA1 P41/TMO0/RxD2/ IrRxD P40/TMCI0/TxD2/ IrTxD | I/O port also functioning as 14-bit PWM timer output (PWX1, PWX0), 8-bit timer 0 and 1 input/output (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection input/output (HSYNCO, CSYNCl, HSYNCl), SCI2 input/output (TxD2, RxD2, SCK2), IrDA interface input/output (IrTxD, IrRxD), and I ² C bus interface 1 (option) input/output (SDA1) | I/O port also functioning as 14-bit PWM timer output (PWX1, PWX0), 8-bit timer 0 and 1 input/output (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection input/output (HSYNCO, CSYNCl, HSYNCl), host interface host CPU interrupt request output (HIRQ12, HIRQ1, HIRQ11), SCI2 input/output (TxD2, RxD2, SCK2), IrDA interface input/output (IrTxD, IrRxD), and I ² C bus interface 1 (option) input/output (SDA1) | |
| Port 5 | • 3-bit I/O port | P52/SCK0/SCL0 P51/RxD0 P50/TxD0 | I/O port also functioning as SCI0 input/output (TxD0, RxD0, SCK0) and I ² C bus interface 0 (option) input/output (SCL0) | | |
| Port 6 | • 8-bit I/O port | P67/ $\overline{\text{IRQ7}}$ /TMOX/ $\overline{\text{KIN7}}$ /CIN7 P66/ $\overline{\text{IRQ6}}$ /FTOB/ $\overline{\text{KIN6}}$ /CIN6 P65/FTID/ $\overline{\text{KIN5}}$ / CIN5 P64/FTIC/ $\overline{\text{KIN4}}$ / CIN4/CLAMPO P63/FTIB/ $\overline{\text{KIN3}}$ / CIN3/VFBACKI P62/FTIA/TMIY/ $\overline{\text{KIN2}}$ /CIN2/VSYNCl P61/FTOA/ $\overline{\text{KIN1}}$ / CIN1/VSYNCO P60/FTCI/TMIX/ $\overline{\text{KIN0}}$ /CIN0/ HFBACKI | I/O port also functioning as external interrupt input ($\overline{\text{IRQ7}}$, $\overline{\text{IRQ6}}$), FRT input/output (FTCI, FTOA, FTIA, FTIB, FTIC, FTID, FTOB), 8-bit timer X and Y input/output (TMOX, TMIX, TMIY), timer connection input/output (CLAMPO, VFBACKI, VSYNCl, VSYNCO, HFBACKI), key-sense interrupt input ($\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$), and expansion A/D converter input (CIN7 to CIN0) | | |

| Port | Description | Pins | Expanded Modes | | Single-Chip Mode |
|--------|--------------------|---|---|---|--|
| | | | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) |
| Port 7 | • 8-bit input port | P77/AN7/DA1 P76/AN6/DA0 P75/AN5 P74/AN4 P73/AN3 P72/AN2 P71/AN1 P70/AN0 | Input port also functioning as A/D converter analog input (AN7 to AN0) and D/A converter analog output (DA1, DA0) | | |
| Port 8 | • 7-bit I/O port | P86/ $\overline{\text{IRQ5}}$ /SCK1/ SCL1 P85/ $\overline{\text{IRQ4}}$ /RxD1 P84/ $\overline{\text{IRQ3}}$ /TxD1 P83 P82/HIFSD P81/ $\overline{\text{CS2}}$ /GA20 P80/HA0 | I/O port also functioning as external interrupt input ($\overline{\text{IRQ5}}$, $\overline{\text{IRQ4}}$, $\overline{\text{IRQ3}}$), SCI1 input/output (TxD1, RxD1, SCK1), and I ² C bus interface 1 (option) input/output (SCL1) | | I/O port also functioning as external interrupt input ($\overline{\text{IRQ5}}$, $\overline{\text{IRQ4}}$, $\overline{\text{IRQ3}}$), SCI1 input/output (TxD1, RxD1, SCK1), host interface control input/output ($\overline{\text{CS2}}$, GA20, HA0, HIFSD), and I ² C bus interface 1 (option) input/output (SCL1) |
| Port 9 | • 8-bit I/O port | P97/ $\overline{\text{WAIT}}$ /SDA0 | I/O port also functioning as expanded data bus control input ($\overline{\text{WAIT}}$) and I ² C bus interface 0 (option) input/output (SDA0) | | I/O port also functioning as I ² C bus interface 0 (option) input/output (SDA0) |
| | | P96/ ϕ /EXCL | When DDR = 0: input port or EXCL input When DDR = 1 (after reset): ϕ output | When DDR = 0 (after reset): input port or EXCL input When DDR = 1: ϕ output | |
| | | P95/ $\overline{\text{AS}}$ / $\overline{\text{IOS}}$ / $\overline{\text{CS1}}$ P94/ $\overline{\text{WR}}$ / $\overline{\text{IOW}}$ P93/ $\overline{\text{RD}}$ / $\overline{\text{IOR}}$ | Expanded data bus control output ($\overline{\text{AS}}$ / $\overline{\text{IOS}}$, $\overline{\text{WR}}$, $\overline{\text{RD}}$) | | I/O port also functioning as host interface control input ($\overline{\text{CS1}}$, $\overline{\text{IOW}}$, $\overline{\text{IOR}}$) |
| | | P92/ $\overline{\text{IRQ0}}$ P91/ $\overline{\text{IRQ1}}$ | I/O port also functioning as external interrupt input ($\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$) | | |
| | | P90/ $\overline{\text{IRQ2}}$ / $\overline{\text{ADTRG}}$ / $\overline{\text{ECS2}}$ | I/O port also functioning as external interrupt input ($\overline{\text{IRQ2}}$), and A/D converter external trigger input ($\overline{\text{ADTRG}}$) | I/O port also functioning as external interrupt input ($\overline{\text{IRQ2}}$), A/D converter external trigger input ($\overline{\text{ADTRG}}$), and host interface control input ($\overline{\text{ECS2}}$) | |

Table 8.2 H8S/2134 Group Port Functions

| Port | Description | Pins | Expanded Modes | | Single-Chip Mode |
|--------|--|---|--|--|------------------------------|
| | | | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) |
| Port 1 | <ul style="list-style-type: none"> 8-bit I/O port On-chip MOS input pull-ups LED drive capability | P17 to P10/ A7 to A0 | Lower address output (A7 to A0) | When DDR = 0 (after reset): input port When DDR = 1: lower address output (A7 to A0) | I/O port |
| Port 2 | <ul style="list-style-type: none"> 8-bit I/O port On-chip MOS input pull-ups LED drive capability | P27 to P20/ A15 to A8 | Upper address output (A15 to A8) | When DDR = 0 (after reset): input port When DDR = 1: upper address output (A15 to A8) or output port (P27 to P24) | I/O port |
| Port 3 | <ul style="list-style-type: none"> 8-bit I/O port On-chip MOS input pull-ups LED drive capability | P37 to P30/ D7 to D0 | Data bus input/output (D7 to D0) | | I/O port |
| Port 4 | 8-bit I/O port | P47/PWX1 P46/PWX0 P45/TMR11 P44/TMO1 P43/TMCI1 P42/TMRI0/SCK2 P41/TMO0/RxD2/IrRxD P40/TMCI0/TxD2/IrTxD | I/O port also functioning as 14-bit PWM timer output (PWX1, PWX0), 8-bit timer 0 and 1 input/output (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), SCI2 input/output (TxD2, RxD2, SCK2), and IrDA interface input/output (IrTxD, IrRxD) | | |
| Port 5 | 3-bit I/O port | P52/SCK0 P51/RxD0 P50/TxD0 | I/O port also functioning as SCI0 input/output (TxD0, RxD0, SCK0) | | |

| Port | Description | Pins | Expanded Modes | | Single-Chip Mode |
|--------|--------------------|--|--|------------------------------|------------------------------|
| | | | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) |
| Port 6 | • 8-bit I/O port | P67/ $\overline{\text{IRQ7}}$ /KIN7/ CIN7 P66/ $\overline{\text{IRQ6}}$ /FTOB/ KIN6/CIN6 P65/FTID/ $\overline{\text{KIN5}}$ / CIN5 P64/FTIC/ $\overline{\text{KIN4}}$ / CIN4 P63/FTIB/ $\overline{\text{KIN3}}$ / CIN3 P62/FTIA/TMIY/ KIN2/CIN2 P61/FTOA/ $\overline{\text{KIN1}}$ / CIN1 P60/FTCI/ $\overline{\text{KIN0}}$ / CIN0 | I/O port also functioning as external interrupt input ($\overline{\text{IRQ7}}$, $\overline{\text{IRQ6}}$), FRT input/output (FTCI, FTOA, FTIA, FTIB, FTIC, FTID, FTOB), 8-bit timer Y input (TMIY), key-sense interrupt input (KIN7 to KIN0), and expansion A/D converter input (CIN7 to CIN0) | | |
| Port 7 | • 8-bit input port | P77/AN7/DA1 P76/AN6/DA0 P75/AN5 P74/AN4 P73/AN3 P72/AN2 P71/AN1 P70/AN0 | Input port also functioning as A/D converter analog input (AN7 to AN0) and D/A converter analog output (DA1, DA0) | | |
| Port 8 | • 7-bit I/O port | P86/ $\overline{\text{IRQ5}}$ /SCK1 P85/ $\overline{\text{IRQ4}}$ /RxD1 P84/ $\overline{\text{IRQ3}}$ /TxD1 P83 P82 P81 P80 | I/O port also functioning as external interrupt input ($\overline{\text{IRQ5}}$, $\overline{\text{IRQ4}}$, $\overline{\text{IRQ3}}$) and SCI1 input/output (TxD1, RxD1, SCK1) | | |

| Port | Description | Pins | Expanded Modes | | Single-Chip Mode |
|--------|------------------|---|--|---|---|
| | | | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) |
| Port 9 | • 8-bit I/O port | P97/ $\overline{\text{WAIT}}$ | I/O port also functioning as expanded data bus control input ($\overline{\text{WAIT}}$) | | I/O port |
| | | P96/ ϕ /EXCL | When DDR = 0: input port or EXCL input When DDR = 1 (after reset): ϕ output | When DDR = 0 (after reset): input port or EXCL input When DDR = 1: ϕ output | |
| | | P95/ $\overline{\text{AS}}/\overline{\text{IOS}}$ P94/ $\overline{\text{WR}}$ P93/ $\overline{\text{RD}}$ | Expanded data bus control output($\overline{\text{AS}}/\overline{\text{IOS}}$, $\overline{\text{WR}}$, $\overline{\text{RD}}$) | | I/O port |
| | | P92/ $\overline{\text{IRQ0}}$ P91/ $\overline{\text{IRQ1}}$ | I/O port also functioning as external interrupt input ($\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$) | | |
| | | P90/ $\overline{\text{IRQ2}}/\overline{\text{ADTRG}}$ | I/O port also functioning as external interrupt input ($\overline{\text{IRQ2}}$), and A/D converter external trigger input ($\overline{\text{ADTRG}}$) | | I/O port also functioning as external interrupt input ($\overline{\text{IRQ2}}$) and A/D converter external trigger input ($\overline{\text{ADTRG}}$) |

8.2 Port 1

8.2.1 Overview

Port 1 is an 8-bit I/O port. Port 1 pins also function as address bus output pins (A7 to A0), and as 8-bit PWM output pins (PW7 to PW0) (H8S/2138 Group only). Port 1 functions change according to the operating mode. Port 1 has an on-chip MOS input pull-up function that can be controlled by software.

Figure 8.1 shows the port 1 pin configuration.

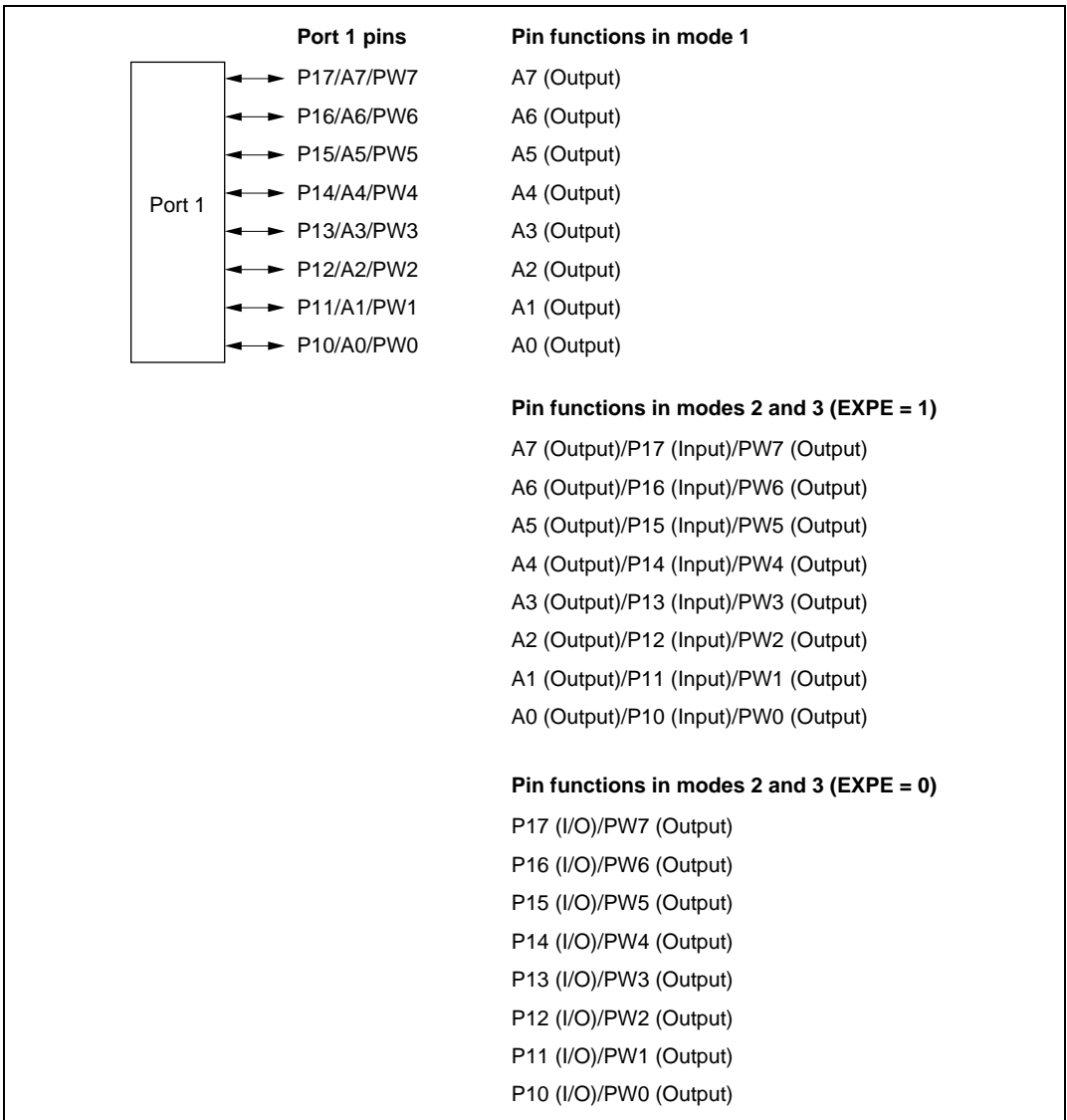


Figure 8.1 Port 1 Pin Functions

8.2.2 Register Configuration

Table 8.3 shows the port 1 register configuration.

Table 8.3 Port 1 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|-------------------------------------|--------------|-----|---------------|----------|
| Port 1 data direction register | P1DDR | W | H'00 | H'FFB0 |
| Port 1 data register | P1DR | R/W | H'00 | H'FFB2 |
| Port 1 MOS pull-up control register | P1PCR | R/W | H'00 | H'FFAC |

Note: * Lower 16 bits of the address.

Port 1 Data Direction Register (P1DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P17DDR | P16DDR | P15DDR | P14DDR | P13DDR | P12DDR | P11DDR | P10DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P1DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 1. P1DDR cannot be read; if it is, an undefined value will be returned.

P1DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. The address output pins maintain their output state in a transition to software standby mode.

- **Mode 1**
The corresponding port 1 pins are address outputs, regardless of the P1DDR setting.
In hardware standby mode, the address outputs go to the high-impedance state.
- **Modes 2 and 3 (EXPE = 1)**
The corresponding port 1 pins are address outputs or PWM outputs when P1DDR bits are set to 1, and input ports when cleared to 0.
- **Modes 2 and 3 (EXPE = 0)**
The corresponding port 1 pins are output ports or PWM outputs when P1DDR bits are set to 1, and input ports when cleared to 0.

Port 1 Data Register (P1DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P17DR | P16DR | P15DR | P14DR | P13DR | P12DR | P11DR | P10DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P1DR is an 8-bit readable/writable register that stores output data for the port 1 pins (P17 to P10). If a port 1 read is performed while P1DDR bits are set to 1, the P1DR values are read, regardless of the actual pin states. If a port 1 read is performed while P1DDR bits are cleared to 0, the pin states are read.

P1DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 1 MOS Pull-Up Control Register (P1PCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P17PCR | P16PCR | P15PCR | P14PCR | P13PCR | P12PCR | P11PCR | P10PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P1PCR is an 8-bit readable/writable register that controls the port 1 on-chip MOS input pull-ups on a bit-by-bit basis.

In modes 2 and 3, the MOS input pull-up is turned on when a P1PCR bit is set to 1 while the corresponding P1DDR bit is cleared to 0 (input port setting).

P1PCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.2.3 Pin Functions in Each Mode

Mode 1: In mode 1, port 1 pins automatically function as address outputs. The port 1 pin functions are shown in figure 8.2.

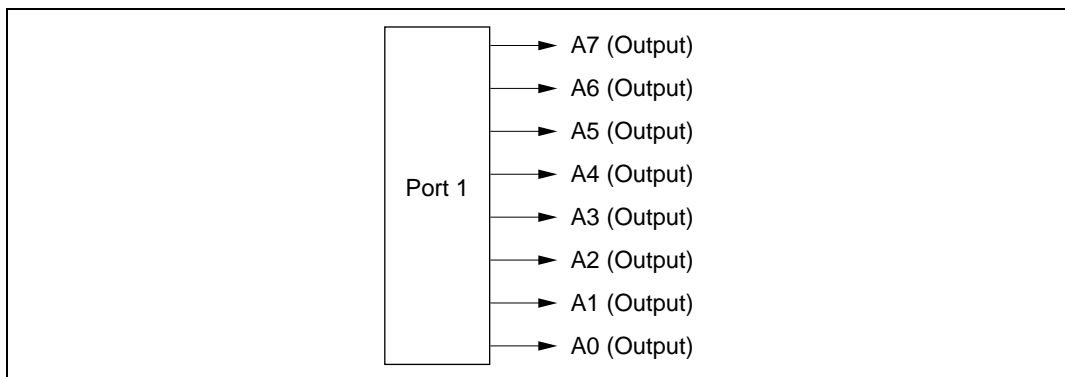


Figure 8.2 Port 1 Pin Functions (Mode 1)

Modes 2 and 3 (EXPE = 1): In modes 2 and 3 (when EXPE = 1), port 1 pins function as address outputs, PWM outputs, or input ports, and input or output can be specified on a bit-by-bit basis. When a bit in P1DDR is set to 1, the corresponding pin functions as an address output or PWM output, and when cleared to 0, as an input port.

The port 1 pin functions are shown in figure 8.3.

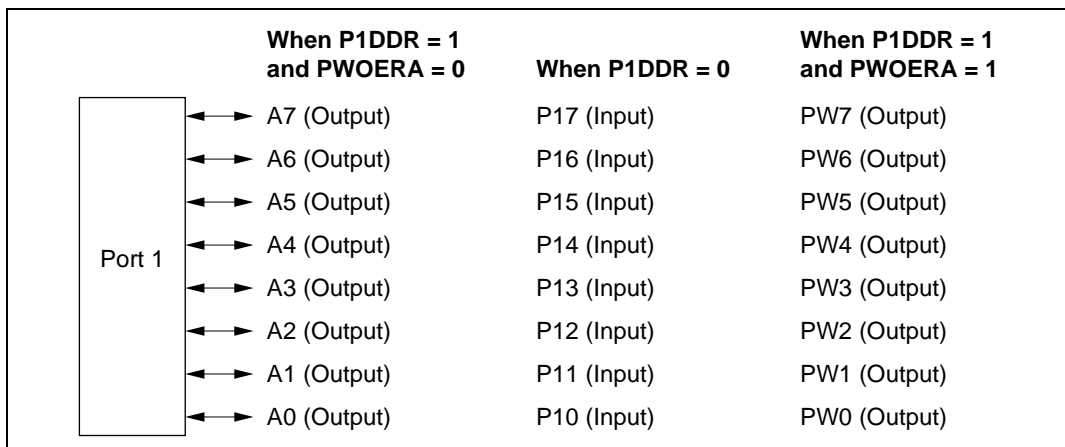


Figure 8.3 Port 1 Pin Functions (Modes 2 and 3 (EXPE = 1))

Modes 2 and 3 (EXPE = 0): In modes 2 and 3 (when EXPE = 0), port 1 pins function as PWM outputs or I/O ports, and input or output can be specified on a bit-by-bit basis. When a bit in P1DDR is set to 1, the corresponding pin functions as a PWM output or output port, and when cleared to 0, as an input port.

The port 1 pin functions are shown in figure 8.4.

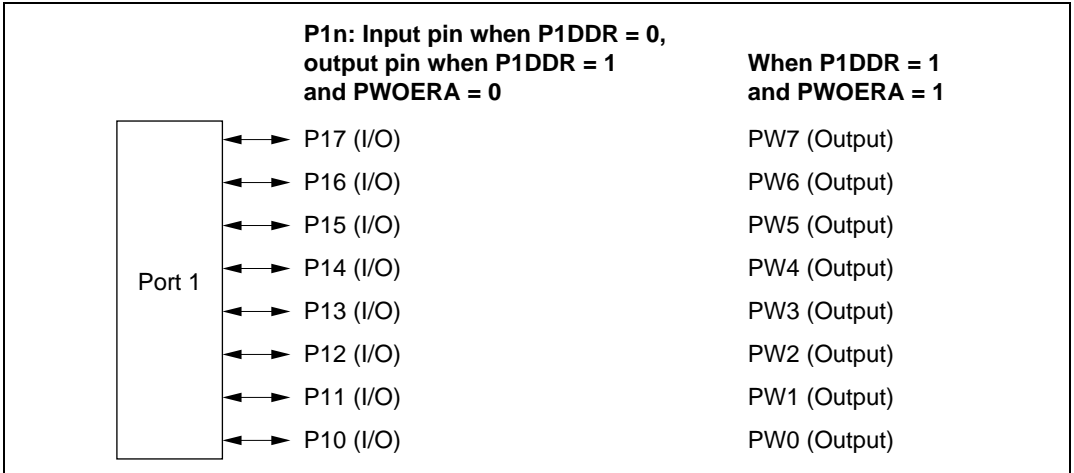


Figure 8.4 Port 1 Pin Functions (Modes 2 and 3 (EXPE = 0))

8.2.4 MOS Input Pull-Up Function

Port 1 has an on-chip MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in modes 2 and 3, and can be specified as on or off on a bit-by-bit basis.

When a P1DDR bit is cleared to 0 in mode 2 or 3, setting the corresponding P1PCR bit to 1 turns on the MOS input pull-up for that pin.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.4 summarizes the MOS input pull-up states.

Table 8.4 MOS Input Pull-Up States (Port 1)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|------|-------|-----------------------|-----------------------|---------------------|
| 1 | Off | Off | Off | Off |
| 2, 3 | Off | Off | On/Off | On/Off |

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P1DDR = 0 and P1PCR = 1; otherwise off.

8.3 Port 2

8.3.1 Overview

Port 2 is an 8-bit I/O port. Port 2 pins also function as address bus output pins (A15 to A8), 8-bit PWM output pins (PW15 to PW8) (H8S/2138 Group only), and the timer connection output pin (CBLANK) (H8S/2138 Group only). Port 2 functions change according to the operating mode. Port 2 has an on-chip MOS input pull-up function that can be controlled by software.

Figure 8.5 shows the port 2 pin configuration.

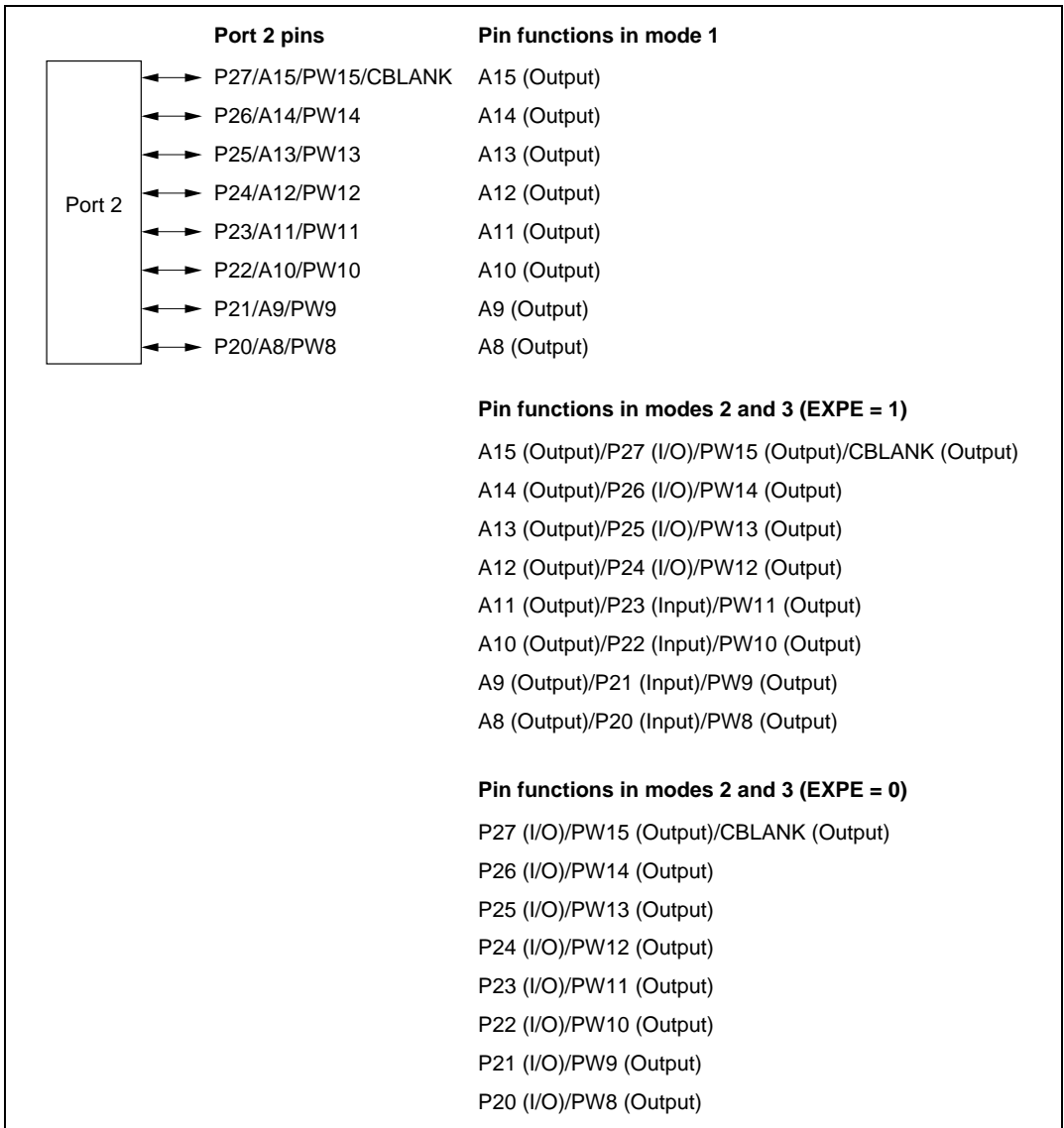


Figure 8.5 Port 2 Pin Functions

8.3.2 Register Configuration

Table 8.5 shows the port 2 register configuration.

Table 8.5 Port 2 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|-------------------------------------|--------------|-----|---------------|----------|
| Port 2 data direction register | P2DDR | W | H'00 | H'FFB1 |
| Port 2 data register | P2DR | R/W | H'00 | H'FFB3 |
| Port 2 MOS pull-up control register | P2PCR | R/W | H'00 | H'FFAD |

Note: * Lower 16 bits of the address.

Port 2 Data Direction Register (P2DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P27DDR | P26DDR | P25DDR | P24DDR | P23DDR | P22DDR | P21DDR | P20DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P2DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 2. P2DDR cannot be read; if it is, an undefined value will be returned.

P2DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. The address output pins maintain their output state in a transition to software standby mode.

- Mode 1

The corresponding port 2 pins are address outputs, regardless of the P2DDR setting.

In hardware standby mode, the address outputs go to the high-impedance state.

- Modes 2 and 3 (EXPE = 1)

The corresponding port 2 pins are address outputs or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0. P27 to P24 are switched from address outputs to output ports by setting the IOSE bit to 1.

P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting, but to ensure normal access to external space, P27 should not be set as an on-chip supporting module output pin when port 2 pins are used as address output pins.

- Modes 2 and 3 (EXPE = 0)

The corresponding port 2 pins are output ports or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0.

P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting.

Port 2 Data Register (P2DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P27DR | P26DR | P25DR | P24DR | P23DR | P22DR | P21DR | P20DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P2DR is an 8-bit readable/writable register that stores output data for the port 2 pins (P27 to P20). If a port 2 read is performed while P2DDR bits are set to 1, the P2DR values are read directly, regardless of the actual pin states. If a port 2 read is performed while P2DDR bits are cleared to 0, the pin states are read.

P2DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 2 MOS Pull-Up Control Register (P2PCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P27PCR | P26PCR | P25PCR | P24PCR | P23PCR | P22PCR | P21PCR | P20PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P2PCR is an 8-bit readable/writable register that controls the port 2 on-chip MOS input pull-ups on a bit-by-bit basis.

In modes 2 and 3, the MOS input pull-up is turned on when a P2PCR bit is set to 1 while the corresponding P2DDR bit is cleared to 0 (input port setting).

P2PCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.3.3 Pin Functions in Each Mode

Mode 1: In mode 1, port 2 pins automatically function as address outputs. The port 2 pin functions are shown in figure 8.6.

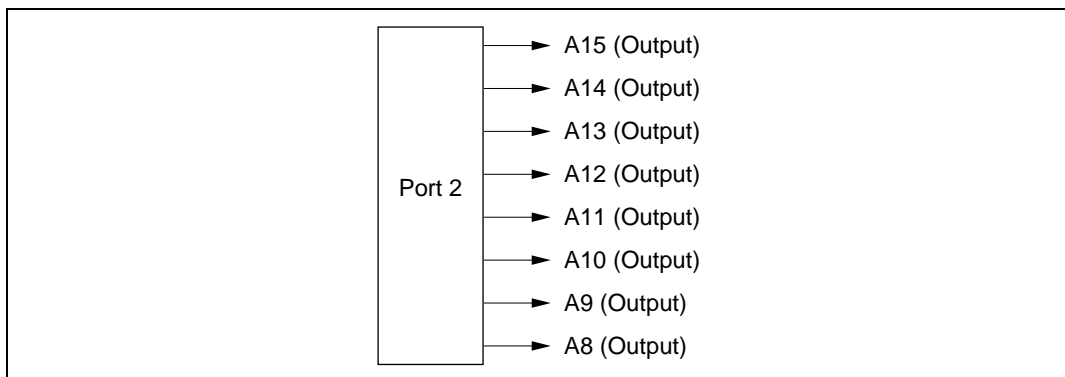


Figure 8.6 Port 2 Pin Functions (Mode 1)

Modes 2 and 3 (EXPE = 1): In modes 2 and 3 (when EXPE = 1), port 2 pins function as address outputs, PWM outputs, or I/O ports, and input or output can be specified on a bit-by-bit basis. When a bit in P2DDR is set to 1, the corresponding pin functions as an address output or PWM output, and when cleared to 0, as an input port. P27 to P24 are switched from address outputs to output ports by setting the IOSE bit to 1. P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting, but to ensure normal access to external space, P27 should not be set as an on-chip supporting module output pin when port 2 pins are used as address output pins.

The port 2 pin functions are shown in figure 8.7.

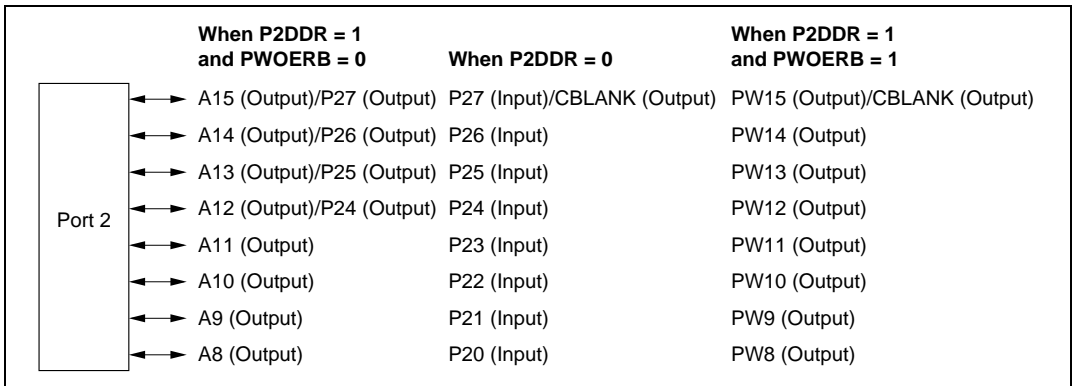


Figure 8.7 Port 2 Pin Functions (Modes 2 and 3 (EXPE = 1))

Modes 2 and 3 (EXPE = 0): In modes 2 and 3 (when EXPE = 0), port 2 pins function as PWM outputs (P27 can also function as the timer connection output (CBLANK)) or I/O ports, and input or output can be specified on a bit-by-bit basis. When a bit in P2DDR is set to 1, the corresponding pin functions as a PWM output or output port, and when cleared to 0, as an input port. P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting.

The port 2 pin functions are shown in figure 8.8.

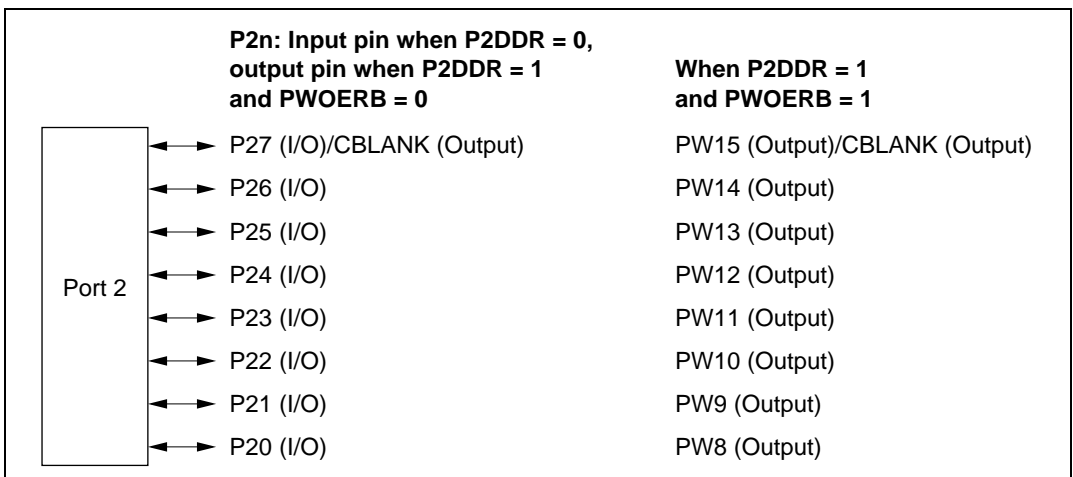


Figure 8.8 Port 2 Pin Functions (Modes 2 and 3 (EXPE = 0))

8.3.4 MOS Input Pull-Up Function

Port 2 has an on-chip MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in modes 2 and 3, and can be specified as on or off on a bit-by-bit basis.

When a P2DDR bit is cleared to 0 in mode 2 or 3, setting the corresponding P2PCR bit to 1 turns on the MOS input pull-up for that pin.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.6 summarizes the MOS input pull-up states.

Table 8.6 MOS Input Pull-Up States (Port 2)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|-------------|--------------|------------------------------|------------------------------|----------------------------|
| 1 | Off | Off | Off | Off |
| 2, 3 | Off | Off | On/Off | On/Off |

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P2DDR = 0 and P2PCR = 1; otherwise off.

8.4 Port 3

8.4.1 Overview

Port 3 is an 8-bit I/O port. Port 3 pins also function as host data bus I/O pins (HDB7 to HDB0) (H8S/2138 Group only), and as data bus I/O pins. Port 3 functions change according to the operating mode. Port 3 has an on-chip MOS input pull-up function that can be controlled by software.

Figure 8.9 shows the port 3 pin configuration.

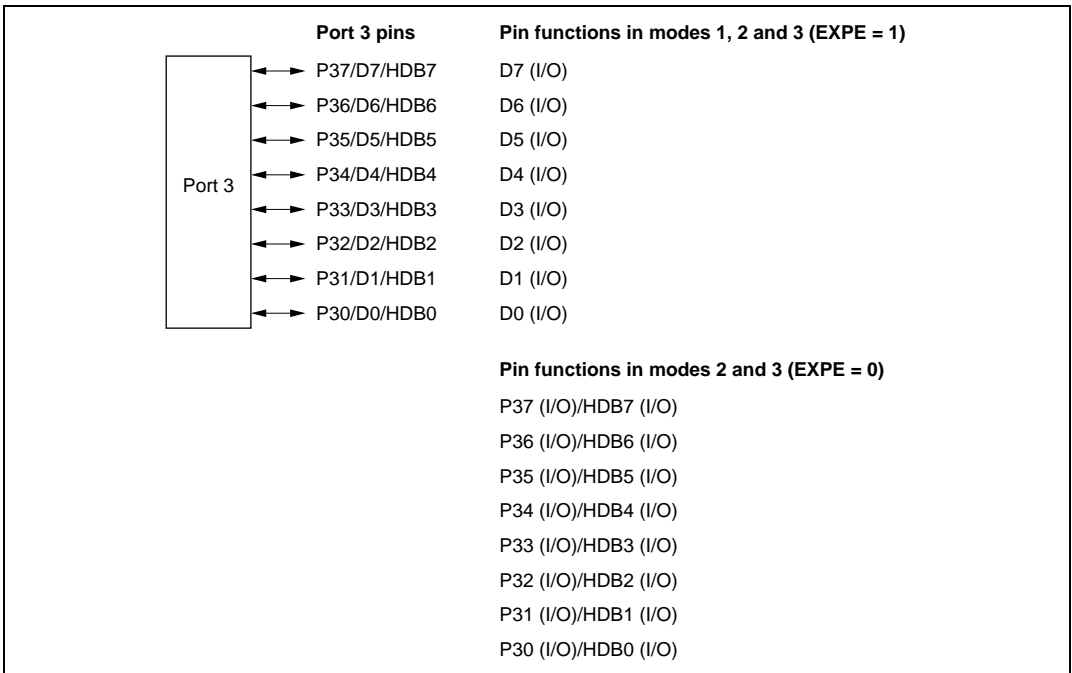


Figure 8.9 Port 3 Pin Functions

8.4.2 Register Configuration

Table 8.7 shows the port 3 register configuration.

Table 8.7 Port 3 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|-------------------------------------|--------------|-----|---------------|----------|
| Port 3 data direction register | P3DDR | W | H'00 | H'FFB4 |
| Port 3 data register | P3DR | R/W | H'00 | H'FFB6 |
| Port 3 MOS pull-up control register | P3PCR | R/W | H'00 | H'FFAE |

Note: * Lower 16 bits of the address.

Port 3 Data Direction Register (P3DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P37DDR | P36DDR | P35DDR | P34DDR | P33DDR | P32DDR | P31DDR | P30DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P3DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 3. P3DDR cannot be read; if it is, an undefined value will be returned.

P3DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

- Modes 1, 2, and 3 (EXPE = 1)

The input/output direction specified by P3DDR is ignored, and pins automatically function as data I/O pins.

After a reset, and in hardware standby mode or software standby mode, the data I/O pins go to the high-impedance state.

- Modes 2 and 3 (EXPE = 0)

The corresponding port 3 pins are output ports when P3DDR bits are set to 1, and input ports when cleared to 0.

Port 3 Data Register (P3DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P37DR | P36DR | P35DR | P34DR | P33DR | P32DR | P31DR | P30DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P3DR is an 8-bit readable/writable register that stores output data for the port 3 pins (P37 to P30). If a port 3 read is performed while P3DDR bits are set to 1, the P3DR values are read directly, regardless of the actual pin states. If a port 3 read is performed while P3DDR bits are cleared to 0, the pin states are read.

P3DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 3 MOS Pull-Up Control Register (P3PCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P37PCR | P36PCR | P35PCR | P34PCR | P33PCR | P32PCR | P31PCR | P30PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P3PCR is an 8-bit readable/writable register that controls the port 3 on-chip MOS input pull-ups on a bit-by-bit basis.

In modes 2 and 3 (when EXPE = 0), the MOS input pull-up is turned on when a P3PCR bit is set to 1 while the corresponding P3DDR bit is cleared to 0 (input port setting).

P3PCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

The MOS input pull-up function cannot be used in slave mode (when the host interface is enabled).

8.4.3 Pin Functions in Each Mode

Modes 1, 2, and 3 (EXPE = 1): In modes 1, 2, and 3 (when EXPE = 1), port 3 pins automatically function as data I/O pins. The port 3 pin functions are shown in figure 8.10.

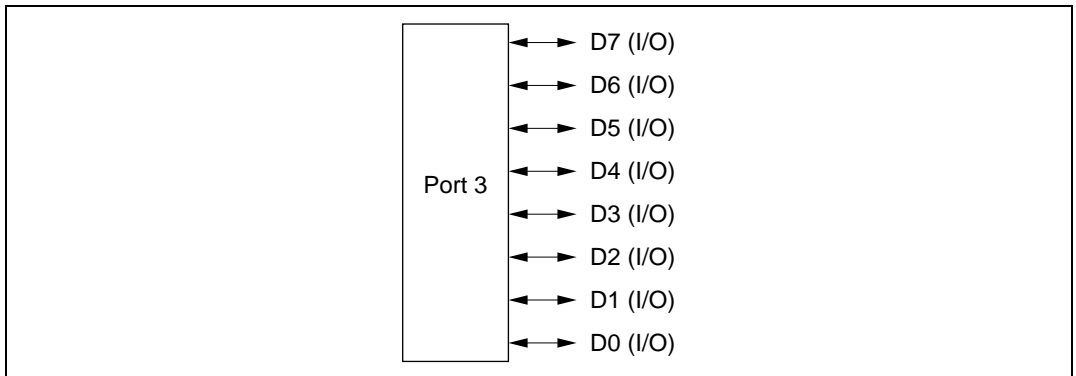


Figure 8.10 Port 3 Pin Functions (Modes 1, 2, and 3 (EXPE = 1))

Modes 2 and 3 (EXPE = 0): In modes 2 and 3 (when EXPE = 0), port 3 functions as host interface data bus I/O pins (HDB7 to HDB0) or as I/O ports. When the HI12E bit is set to 1 in SYSCR2 and a transition is made to slave mode, port 3 functions as the host interface data bus. In slave mode, P3DR and P3DDR should be cleared to H'00. When the HI12E bit is cleared to 0, port 3 functions as an I/O port, and input or output can be specified on a bit-by-bit basis. When a bit in P3DDR is set to 1, the corresponding pin functions as an output port, and when cleared to 0, as an input port.

The port 3 pin functions are shown in figure 8.11.

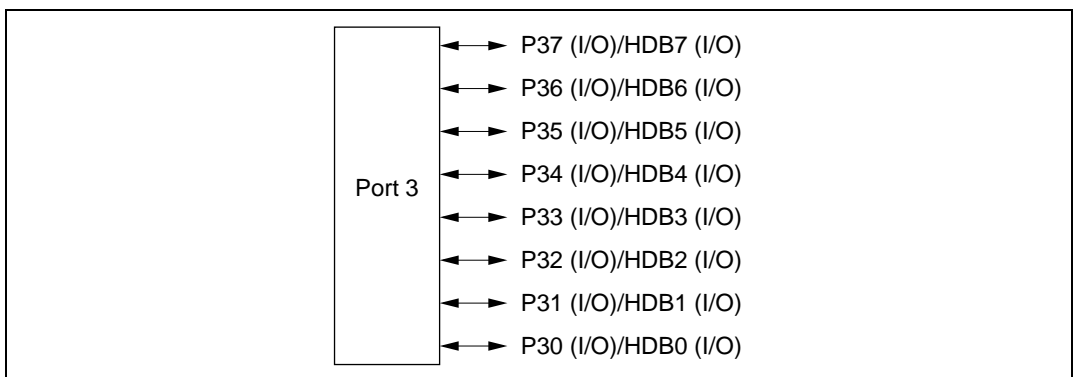


Figure 8.11 Port 3 Pin Functions (Modes 2 and 3 (EXPE = 0))

8.4.4 MOS Input Pull-Up Function

Port 3 has an on-chip MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in modes 2 and 3 (when EXPE = 0), and can be specified as on or off on a bit-by-bit basis.

When a P3DDR bit is cleared to 0 in mode 2 or 3 (when EXPE = 0), setting the corresponding P3PCR bit to 1 turns on the MOS input pull-up for that pin.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.8 summarizes the MOS input pull-up states.

Table 8.8 MOS Input Pull-Up States (Port 3)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|--------------------|--------------|------------------------------|------------------------------|----------------------------|
| 1, 2, 3 (EXPE = 1) | Off | Off | Off | Off |
| 2, 3 (EXPE = 0) | Off | Off | On/Off | On/Off |

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P3DDR = 0 and P3PCR = 1; otherwise off.

8.5 Port 4

8.5.1 Overview

Port 4 is an 8-bit I/O port. Port 4 pins also function as 14-bit PWM output pins (PWX1, PWX0), 8-bit timer 0 and 1 (TMR0, TMR1) I/O pins (TMC10, TMRI0, TMO0, TMC11, TMR11, TMO1), timer connection I/O pins (CSYNCI, HSYNCI, HSYNCO) (H8S/2138 Group only), SCI2 I/O pins (TxD2, RxD2, SCK2), IrDA interface I/O pins (IrTxD, IrRxD), host interface output pins (HIRQ12, HIRQ1, HIRQ11) (H8S/2138 Group only), and the IIC1 I/O pin (SDA1) (option in H8S/2138 Group only). Port 4 pin functions are the same in all operating modes.

Figure 8.12 shows the port 4 pin configuration.

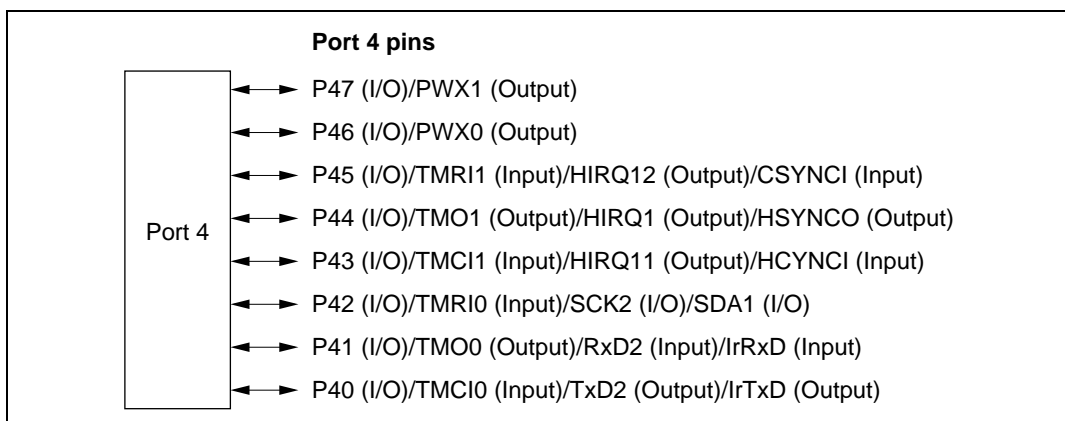


Figure 8.12 Port 4 Pin Functions

8.5.2 Register Configuration

Table 8.9 shows the port 4 register configuration.

Table 8.9 Port 4 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|--------------------------------|--------------|-----|---------------|----------|
| Port 4 data direction register | P4DDR | W | H'00 | H'FFB5 |
| Port 4 data register | P4DR | R/W | H'00 | H'FFB7 |

Note: * Lower 16 bits of the address.

Port 4 Data Direction Register (P4DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P47DDR | P46DDR | P45DDR | P44DDR | P43DDR | P42DDR | P41DDR | P40DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P4DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 4. P4DDR cannot be read; if it is, an undefined value will be returned.

When a bit in P4DDR is set to 1, the corresponding pin functions as an output port, and when cleared to 0, as an input port.

P4DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. As 14-bit PWM and SCI2 are initialized in software standby mode, the pin states are determined by the TMR0, TMR1, HIF, IIC1, P4DDR, and P4DR specifications.

Port 4 Data Register (P4DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P47DR | P46DR | P45DR | P44DR | P43DR | P42DR | P41DR | P40DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P4DR is an 8-bit readable/writable register that stores output data for the port 4 pins (P47 to P40). If a port 4 read is performed while P4DDR bits are set to 1, the P4DR values are read directly, regardless of the actual pin states. If a port 4 read is performed while P4DDR bits are cleared to 0, the pin states are read.

P4DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.5.3 Pin Functions

Port 4 pins also function as 14-bit PWM output pins (PWX1, PWX0), 8-bit timer 0 and 1 (TMR0, TMR1) I/O pins (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection I/O pins (CSYNCI, HSYNCI, HSYNCO), SCI2 I/O pins (TxD2, RxD2, SCK2), IrDA interface I/O pins (IrTxD, IrRx), host interface output pins (HIRQ12, HIRQ1, HIRQ11), and the IIC1 I/O pin (SDA1). The port 4 pin functions are shown in table 8.10.

Table 8.10 Port 4 Pin Functions

| Pin | Selection Method and Pin Functions | | | | |
|-----------------------------|--|-----------------------------------|----------------|------------------|--------------------------------------|
| P47/PWX1 | The pin function is switched as shown below according to the combination of bit OEB in DACR of 14-bit PWM, and bit P47DDR. | | | | |
| | OEB | 0 | | | 1 |
| | P47DDR | 0 | 1 | | — |
| | Pin function | P47 input pin | P47 output pin | | PWX1 output pin |
| P46/PWX0 | The pin function is switched as shown below according to the combination of bit OEA in DACR of 14-bit PWM, and bit P46DDR. | | | | |
| | OEA | 0 | | | 1 |
| | P46DDR | 0 | 1 | | — |
| | Pin function | P46 input pin | P46 output pin | | PWX0 output pin |
| P45/TMRI1/ HIRQ12/CSYNCl | The pin function is switched as shown below according to the combination of the operating mode and bit P45DDR. | | | | |
| | P45DDR | 0 | 1 | | |
| | Operating mode | — | Not slave mode | | Slave mode |
| | Pin function | P45 input pin | P45 output pin | | HIRQ12 output pin |
| | | TMRI1 input pin, CSYNCl input pin | | | |
| | When bits CCLR1 and CCLR0 in TCR1 of TMR1 are set to 1, this pin is used as the TMRI1 input pin. It can also be used as the CSYNCl input pin. | | | | |
| P44/TMO1/ HIRQ1/HSYNCO | The pin function is switched as shown below according to the combination of the operating mode, bits OS3 to OS0 in TCSR of TMR1, bit HOE in TCONRO of the timer connection function, and bit P44DDR. | | | | |
| | HOE | 0 | | | 1 |
| | OS3 to OS0 | All 0 | | Not all 0 | — |
| | P44DDR | 0 | 1 | | — |
| | Operating mode | — | Not slave mode | Slave mode | — |
| | Pin function | P44 input pin | P44 output pin | HIRQ1 output pin | TMO1 output pin HSYNCO output pin |

Pin Selection Method and Pin Functions

P43/TMCI1/
HIRQ11/HSYNCl

The pin function is switched as shown below according to the combination of the operating mode and bit P43DDR.

| | | | | |
|----------------|-----------------------------------|--|----------------|-------------------|
| P43DDR | 0 | | 1 | |
| Operating mode | — | | Not slave mode | Slave mode |
| Pin function | P43 input pin | | P43 output pin | HIRQ11 output pin |
| | TMCI1 input pin, HSYNCl input pin | | | |

When an external clock is selected with bits CKS2 to CKS0 in TCR1 of TMR1, this pin is used as the TMCI1 input pin. It can also be used as the HSYNCl input pin.

P42/TMRI0/
SCK2/SDA1

The pin function is switched as shown below according to the combination of bit ICE in ICCR of IIC1, bits CKE1 and CKE0 in SCR of SCI2, bit C/ \bar{A} in SMR of SCI2, and bit P42DDR.

| | | | | | | |
|--------------|------------------|-------------------|--------------------|--------------------|-------------------|-----------------|
| ICE | 0 | | | | 1 | |
| CKE1 | 0 | | | 1 | 0 | |
| C/ \bar{A} | 0 | | 1 | — | 0 | |
| CKE0 | 0 | | 1 | — | — | 0 |
| P42DDR | 0 | 1 | — | — | — | — |
| Pin function | P42 input pin | P42 output pin | SCK2 output pin | SCK2 output pin | SCK2 input pin | SDA1 I/O pin |
| | TMRI0 input pin | | | | | |

When this pin is used as the SDA1 I/O pin, bits CKE1 and CKE0 in SCR of SCI2 and bit C/ \bar{A} in SMR of SCI2 must all be cleared to 0. SDA1 is an NMOS-only output, and has direct bus drive capability.

When bits CCLR1 and CCLR0 in TCR0 of TMR0 are set to 1, this pin is used as the TMRI0 input pin.

Pin Selection Method and Pin Functions

P41/TMO0/RxD2/IrRxD The pin function is switched as shown below according to the combination of bits OS3 to OS0 in TCSR of TMR0, bit RE in SCR of SCI2 and bit P41DDR.

| | | | | |
|--------------|------------------|-------------------|-------------------------|--------------------|
| OS3 to OS0 | All 0 | | | Not all 0 |
| RE | 0 | | 1 | 0 |
| P41DDR | 0 | 1 | — | — |
| Pin function | P41 input pin | P41 output pin | RxD2/IrRxD input pin | TMO0 output pin |

When this pin is used as the TMO0 output pin, bit RE in SCR of SCI2 must be cleared to 0.

P40/TMC10/TxD2/IrTxD The pin function is switched as shown below according to the combination of bit TE in SCR of SCI2 and bit P40DDR.

| | | | |
|--------------|------------------|-------------------|--------------------------|
| TE | 0 | | 1 |
| P40DDR | 0 | 1 | — |
| Pin function | P40 input pin | P40 output pin | TxD2/IrTxD output pin |
| | TMC10 input pin | | |

When an external clock is selected with bits CKS2 to CKS0 in TCR0 of TMR0, this pin is used as the TMC10 input pin.

8.6 Port 5

8.6.1 Overview

Port 5 is a 3-bit I/O port. Port 5 pins also function as SCI0 I/O pins (TxD0, RxD0, SCK0), and the IIC0 I/O pin (SCL0) (option in H8S/2138 Group only). In the H8S/2138 Group, P52 and SCK0 are NMOS push-pull outputs, and SCL0 is an NMOS open-drain output. Port 5 pin functions are the same in all operating modes.

Figure 8.13 shows the port 5 pin configuration.

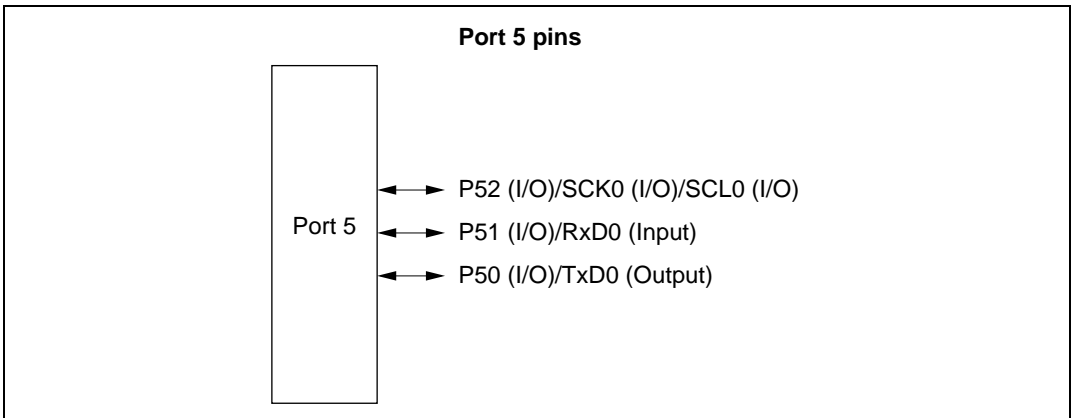


Figure 8.13 Port 5 Pin Functions

8.6.2 Register Configuration

Table 8.11 shows the port 5 register configuration.

Table 8.11 Port 5 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|--------------------------------|--------------|-----|---------------|----------|
| Port 5 data direction register | P5DDR | W | H'F8 | H'FFB8 |
| Port 5 data register | P5DR | R/W | H'F8 | H'FFBA |

Note: * Lower 16 bits of the address.

Port 5 Data Direction Register (P5DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|--------|--------|--------|
| | — | — | — | — | — | P52DDR | P51DDR | P50DDR |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | W | W | W |

P5DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 5. P5DDR cannot be read; if it is, an undefined value will be returned. Bits 7 to 3 are reserved.

Setting a P5DDR bit to 1 makes the corresponding port 5 pin an output pin, while clearing the bit to 0 makes the pin an input pin.

P5DDR is initialized to H'F8 by a reset and in hardware standby mode. It retains its prior state in software standby mode. As SCIO is initialized, the pin states are determined by the IIC0 ICCR, P5DDR, and P5DR specifications.

Port 5 Data Register (P5DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-------|-------|-------|
| | — | — | — | — | — | P52DR | P51DR | P50DR |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | R/W | R/W | R/W |

P5DR is an 8-bit readable/writable register that stores output data for the port 5 pins (P52 to P50). If a port 5 read is performed while P5DDR bits are set to 1, the P5DR values are read directly, regardless of the actual pin states. If a port 5 read is performed while P5DDR bits are cleared to 0, the pin states are read.

Bits 7 to 3 are reserved; they cannot be modified and are always read as 1.

P5DR is initialized to H'F8 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.6.3 Pin Functions

Port 5 pins also function as SCI0 I/O pins (TxD0, RxD0, SCK0) and the IIC0 I/O pin (SCL0). The port 5 pin functions are shown in table 8.12.

Table 8.12 Port 5 Pin Functions

Pin Selection Method and Pin Functions

P52/SCK0/SCL0 The pin function is switched as shown below according to the combination of bits CKE1 and CKE0 in SCR of SCI0, bit C/ \bar{A} in SMR of SCI0, bit ICE in ICCR of IIC0, and bit P52DDR.

| | | | | | | |
|--------------|------------------|-------------------|--------------------|--------------------|-------------------|-----------------|
| ICE | 0 | | | | | 1 |
| CKE1 | 0 | | | 1 | 0 | 0 |
| C/ \bar{A} | 0 | | 1 | — | — | 0 |
| CKE0 | 0 | | 1 | — | — | 0 |
| P52DDR | 0 | 1 | — | — | — | — |
| Pin function | P52 input pin | P52 output pin | SCK0 output pin | SCK0 output pin | SCK0 input pin | SCL0 I/O pin |

When this pin is used as the SCL0 I/O pin, bits CKE1 and CKE0 in SCR of SCI0 and bit C/ \bar{A} in SMR of SCI0 must all be cleared to 0.

SCL0 is an NMOS open-drain output, and has direct bus drive capability. In the H8S/2138 Group, when set as the P52 output pin or SCK0 output pin, this pin is an NMOS push-pull output.

P51/RxD0 The pin function is switched as shown below according to the combination of bit RE in SCR of SCI0 and bit P51DDR.

| | | | |
|--------------|---------------|----------------|----------------|
| RE | 0 | | 1 |
| P51DDR | 0 | 1 | — |
| Pin function | P51 input pin | P51 output pin | RxD0 input pin |

P50/TxD0 The pin function is switched as shown below according to the combination of bit TE in SCR of SCI0 and bit P50DDR.

| | | | |
|--------------|---------------|----------------|-----------------|
| TE | 0 | | 1 |
| P50DDR | 0 | 1 | — |
| Pin function | P50 input pin | P50 output pin | TxD0 output pin |

8.7 Port 6

8.7.1 Overview

Port 6 is an 8-bit I/O port. Port 6 pins also function as the 16-bit free-running timer (FRT) I/O pins (FTOA, FTOB, FTIA to FTID, FTIC), timer X (TMRX) I/O pins (TMOX, TMIX) (H8S/2138 Group only), the timer Y (TMRY) input pin (TMIY), timer connection I/O pins (HFBACKI, VSYNCl, VSYNCO, VFBACKI, CLAMPO) (H8S/2138 Group only), key-sense interrupt input pins ($\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$), expansion A/D converter input pins (CIN7 to CIN0), and external interrupt input pins ($\overline{\text{IRQ7}}$, $\overline{\text{IRQ6}}$). In the H8S/2138 Group, the port 6 input level can be switched in four stages. Port 6 pin functions are the same in all operating modes.

Figure 8.14 shows the port 6 pin configuration.

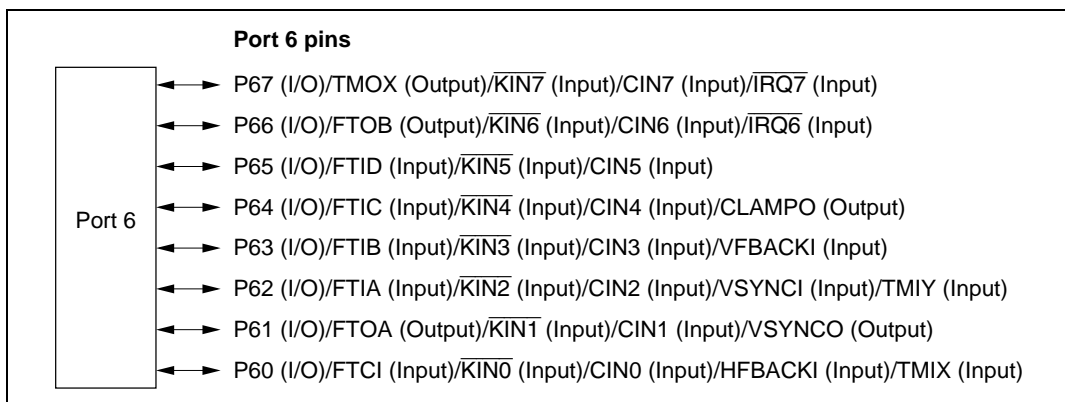


Figure 8.14 Port 6 Pin Functions

8.7.2 Register Configuration

Table 8.13 shows the port 6 register configuration.

Table 8.13 Port 6 Registers

| Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|-------------------------------------|--------------|-----|---------------|-----------------------|
| Port 6 data direction register | P6DDR | W | H'00 | H'FFB9 |
| Port 6 data register | P6DR | R/W | H'00 | H'FFBB |
| Port 6 MOS pull-up control register | KMPCR | R/W | H'00 | H'FFF2 ^{*2} |
| System control register 2 | SYSCR2 | R/W | H'00 | H'FF83 |

Notes: 1. Lower 16 bits of the address.

2. KMPCR has the same address as TICRR/TCORAY of TMRX/TMRY. To select KMPCR, set the HIF bit to 1 in SYSCR and clear the MSTP2 bit to 0 in MSTPCRL.

Port 6 Data Direction Register (P6DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P67DDR | P66DDR | P65DDR | P64DDR | P63DDR | P62DDR | P61DDR | P60DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P6DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 6. P6DDR cannot be read; if it is, an undefined value will be returned.

Setting a P6DDR bit to 1 makes the corresponding port 6 pin an output pin, while clearing the bit to 0 makes the pin an input pin.

P6DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 6 Data Register (P6DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P67DR | P66DR | P65DR | P64DR | P63DR | P62DR | P61DR | P60DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P6DR is an 8-bit readable/writable register that stores output data for the port 6 pins (P67 to P60). If a port 6 read is performed while P6DDR bits are set to 1, the P6DR values are read directly, regardless of the actual pin states. If a port 6 read is performed while P6DDR bits are cleared to 0, the pin states are read.

P6DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 6 MOS Pull-Up Control Register (KMPCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | KM7PCR | KM6PCR | KM5PCR | KM4PCR | KM3PCR | KM2PCR | KM1PCR | KM0PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

KMPCR is an 8-bit readable/writable register that controls the port 6 on-chip MOS input pull-ups on a bit-by-bit basis.

The MOS input pull-up is turned on when a KMPCR bit is set to 1 while the corresponding P6DDR bit is cleared to 0 (input port setting).

KMPCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

System Control Register 2 (SYSCR2) [H8S/2138 Group Only]

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|---|-----|------|------|-------|
| | KWUL1 | KWUL0 | P6PUE | — | SDE | CS4E | CS3E | HI12E |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | — | R/W | R/W | R/W | R/W |

SYSCR2 is an 8-bit readable/writable register that controls port 6 input level selection and the operation of host interface functions.

Only bits 7, 6, and 5 are described here. See section 17.2.2, System Control Register 2 (SYSCR2), for information on bits 4 to 0.

SYSCR2 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Key Wakeup Level 1 and 0 (KWUL1, KWUL0): The port 6 input level setting can be changed by software, using these bits. The setting of these bits also changes the input level of the pin functions multiplexed with port 6.

| Bit 7 | Bit 6 | Description |
|-------|-------|--|
| KWUL1 | KWUL0 | |
| 0 | 0 | Standard input level is selected as port 6 input level (Initial value) |
| | 1 | Input level 1 is selected as port 6 input level |
| 1 | 0 | Input level 2 is selected as port 6 input level |
| | 1 | Input level 3 is selected as port 6 input level |

Bit 5—Port 6 Input Pull-Up Extra (P6PUE): Controls and selects the current specification for the port 6 MOS input pull-up function connected by means of KMPCR settings.

| Bit 5 | Description |
|-------|--|
| P6PUE | |
| 0 | Standard current specification is selected for port 6 MOS input pull-up function (Initial value) |
| 1 | Current-limit specification is selected for port 6 MOS input pull-up function |

8.7.3 Pin Functions

Port 6 pins also function as the 16-bit free-running timer (FRT) I/O pins (FTOA, FTOB, FTIA to FTID, FTIC), timer X (TMRX) I/O pins (TMOX, TMIX), the timer Y (TMRY) input pin (TMIY), timer connection I/O pins (HFBACKI, VSYNCL, VSYNCO, VFBACKI, CLAMPO), key-sense interrupt input pins ($\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$), expansion A/D converter input pins (CIN7 to CIN0), and external interrupt input pins ($\overline{\text{IRQ7}}$, $\overline{\text{IRQ6}}$). In the H8S/2138 Group, the port 6 input level can be switched in four stages. The port 6 pin functions are shown in table 8.14.

Table 8.14 Port 6 Pin Functions

| Pin | Selection Method and Pin Functions | | | |
|--|---|--|----------------|-----------------|
| P67/TMOX/ $\overline{\text{IRQ7}}$ / $\overline{\text{KIN7}}$ /CIN7 | The pin function is switched as shown below according to the combination of bits OS3 to OS0 in TCSR of TMRX and bit P67DDR. | | | |
| | OS3 to OS0 | All 0 | | Not all 0 |
| | P67DDR | 0 | 1 | — |
| | Pin function | P67 input pin | P67 output pin | TMOX output pin |
| | $\overline{\text{IRQ7}}$ input pin, $\overline{\text{KIN7}}$ input pin, CIN7 input pin | | | |
| | This pin is used as the $\overline{\text{IRQ7}}$ input pin when bit IRQ7E is set to 1 in IER. | | | |
| | It can always be used as the $\overline{\text{KIN7}}$ or CIN7 input pin. | | | |
| P66/FTOB/ $\overline{\text{IRQ6}}$ / $\overline{\text{KIN6}}$ /CIN6 | The pin function is switched as shown below according to the combination of bit OEB in TOCR of the FRT and bit P66DDR. | | | |
| | OEB | 0 | | 1 |
| | P66DDR | 0 | 1 | — |
| | Pin function | P66 input pin | P66 output pin | FTOB output pin |
| | $\overline{\text{IRQ6}}$ input pin, $\overline{\text{KIN6}}$ input pin, CIN6 input pin | | | |
| | This pin is used as the $\overline{\text{IRQ6}}$ input pin when bit IRQ6E is set to 1 in IER. | | | |
| | It can always be used as the $\overline{\text{KIN6}}$ or CIN6 input pin. | | | |
| P65/FTID/ $\overline{\text{KIN5}}$ / CIN5 | P65DDR | 0 | | 1 |
| | Pin function | P65 input pin | | P65 output pin |
| | | FTID input pin, $\overline{\text{KIN5}}$ input pin, CIN5 input pin | | |
| | This pin can always be used as the FTID, $\overline{\text{KIN5}}$, or CIN5 input pin. | | | |

Pin Selection Method and Pin FunctionsP64/FTIC/ $\overline{\text{KIN4}}$ /
CIN4/CLAMPO

The pin function is switched as shown below according to the combination of bit CLOE in TCONRO of the timer connection function and bit P64DDR.

| | | | |
|--------------|--|-------------------|----------------------|
| CLOE | 0 | | 1 |
| P64DDR | 0 | 1 | — |
| Pin function | P64 input pin | P64 output pin | CLAMPO output pin |
| | FTIC input pin, $\overline{\text{KIN4}}$ input pin, CIN4 input pin | | |

This pin can always be used as the FTIC, $\overline{\text{KIN4}}$, or CIN4 input pin.P63/FTIB/ $\overline{\text{KIN3}}$ /
CIN3/VFBACKI

| | | |
|--------------|--|----------------|
| P63DDR | 0 | 1 |
| Pin function | P63 input pin | P63 output pin |
| | FTIB input pin, VFBACKI input pin, $\overline{\text{KIN3}}$ input pin, CIN3 input pin | |

This pin can always be used as the FTIB, $\overline{\text{KIN3}}$, CIN3, or VFBACKI input pin.P62/FTIA/TMIY/
 $\overline{\text{KIN2}}$ /CIN2/
VSYNCl

| | | |
|--------------|---|----------------|
| P62DDR | 0 | 1 |
| Pin function | P62 input pin | P62 output pin |
| | FTIA input pin, VSYNCl input pin, TMIY input pin, $\overline{\text{KIN2}}$ input pin, CIN2 input pin | |

This pin can always be used as the FTIA, TMIY, $\overline{\text{KIN2}}$, CIN2, or VSYNCl input pin.P61/FTOA/ $\overline{\text{KIN1}}$ /
CIN1/VSYNCO

The pin function is switched as shown below according to the combination of bit OEA in TOCR of the FRT, bit VOE in TCONRO of the timer connection function, and bit P61DDR.

| | | | |
|--------------|--|-------------------|--------------------|
| VOE | 0 | | 1 |
| OEA | 0 | 1 | 0 |
| P61DDR | 0 | 1 | — |
| Pin function | P61 input pin | P61 output pin | FTOA output pin |
| | $\overline{\text{KIN1}}$ input pin, CIN1 input pin | | |

When this pin is used as the VSYNCO pin, bit OEA in TOCR of the FRT must be cleared to 0.

This pin can always be used as the $\overline{\text{KIN1}}$ or CIN1 input pin.

Pin Selection Method and Pin Functions

 P60/FTCI/TMIX/
 $\overline{\text{KIN0}}$ /CIN0/
 HFBACKI

| | | |
|--------------|---|----------------|
| P60DDR | 0 | 1 |
| Pin function | P60 input pin | P60 output pin |
| | FTCI input pin, HFBACKI input pin, TMIX input pin, $\overline{\text{KIN0}}$ input pin, CIN0 input pin | |

This pin is used as the FTCI input pin when an external clock is selected with bits CKS1 and CKS0 in TCR of the FRT.

It can always be used as the TMIX, $\overline{\text{KIN0}}$, CIN0, or HFBACKI input pin.

8.7.4 MOS Input Pull-Up Function

Port 6 has an on-chip MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in any operating mode, and can be specified as on or off on a bit-by-bit basis.

When a P6DDR bit is cleared to 0, setting the corresponding KMPCR bit to 1 turns on the MOS input pull-up for that pin. The MOS input pull-up current specification can be changed by means of the P6PUE bit. When a pin is designated as an on-chip supporting module output pin, the MOS input pull-up is always off.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.15 summarizes the MOS input pull-up states.

Table 8.15 MOS Input Pull-Up States (Port 6)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|---------|-------|-----------------------|-----------------------|---------------------|
| 1, 2, 3 | Off | Off | On/Off | On/Off |

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P6DDR = 0 and KMPCR = 1; otherwise off.

8.8 Port 7

8.8.1 Overview

Port 7 is an 8-bit input port. Port 7 pins also function as the A/D converter analog input pins (AN0 to AN7) and D/A converter analog output pins (DA0, DA1). Port 7 functions are the same in all operating modes.

Figure 8.15 shows the port 7 pin configuration.

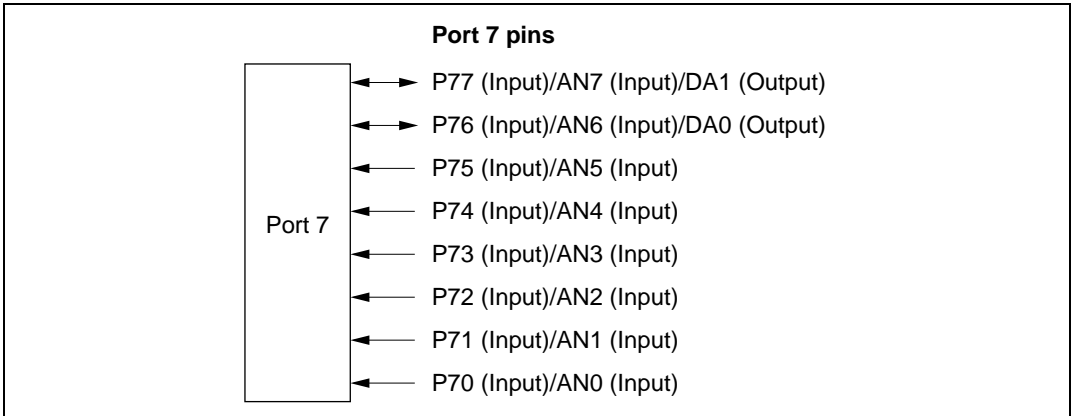


Figure 8.15 Port 7 Pin Functions

8.8.2 Register Configuration

Table 8.16 shows the port 7 register configuration. Port 7 is an input-only port, and does not have a data direction register or data register.

Table 8.16 Port 7 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|----------------------------|--------------|-----|---------------|----------|
| Port 7 input data register | P7PIN | R | Undefined | H'FFBE |

Note: * Lower 16 bits of the address.

Port 7 Input Data Register (P7PIN)

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | P77PIN | P76PIN | P75PIN | P74PIN | P73PIN | P72PIN | P71PIN | P70PIN |
| Initial value | —* | —* | —* | —* | —* | —* | —* | —* |
| Read/Write | R | R | R | R | R | R | R | R |

Note: * Determined by the state of pins P77 to P70.

When a P7PIN read is performed, the pin states are always read.

8.8.3 Pin Functions

Port 7 pins also function as the A/D converter analog input pins (AN0 to AN7) and D/A converter analog output pins (DA0, DA1).

8.9 Port 8

8.9.1 Overview

Port 8 is an 8-bit I/O port. Port 8 pins also function as SC11 I/O pins (TxD1, RxD1, SCK1), the IIC1 I/O pin (SCL1) (option in H8S/2138 Group only), HIF I/O pins ($\overline{CS2}$, GA20, HA0, HIFSD) (H8S/2138 Group only), and external interrupt input pins ($\overline{IRQ5}$ to $\overline{IRQ3}$). Port 8 pin functions are the same in all operating modes. Figure 8.16 shows the port 8 pin configuration.

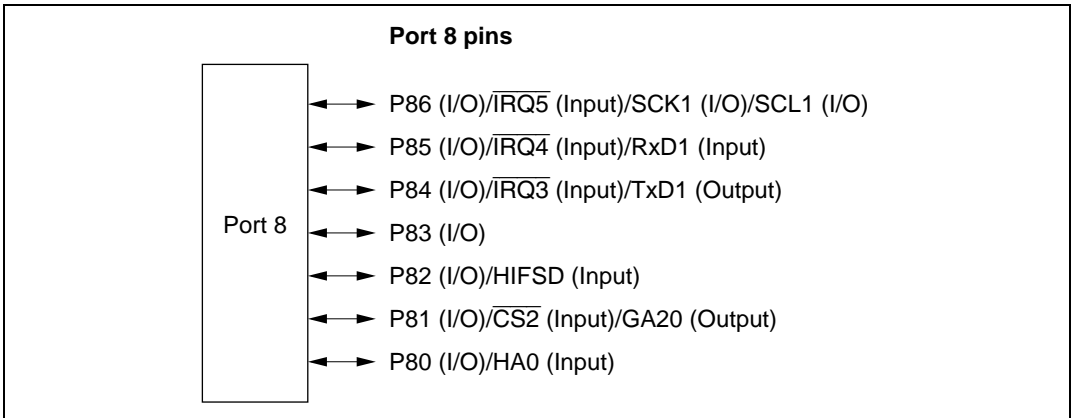


Figure 8.16 Port 8 Pin Functions

8.9.2 Register Configuration

Table 8.17 summarizes the port 8 registers.

Table 8.17 Port 8 Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|--------------------------------|--------------|-----|---------------|----------|
| Port 8 data direction register | P8DDR | W | H'80 | H'FFBD |
| Port 8 data register | P8DR | R/W | H'80 | H'FFBF |

Note: * Lower 16 bits of the address.

Port 8 Data Direction Register (P8DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|--------|--------|--------|--------|--------|--------|--------|
| | — | P86DDR | P85DDR | P84DDR | P83DDR | P82DDR | P81DDR | P80DDR |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | W | W | W | W | W | W | W |

P8DDR is a 7-bit write-only register, the individual bits of which specify input or output for the pins of port 8.

Setting a P8DDR bit to 1 makes the corresponding port 8 pin an output pin, while clearing the bit to 0 makes the pin an input pin.

P8DDR is initialized to H'80 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 8 Data Register (P8DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|-------|-------|-------|-------|-------|-------|-------|
| | — | P86DR | P85DR | P84DR | P83DR | P82DR | P81DR | P80DR |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P8DR is a 7-bit readable/writable register that stores output data for the port 8 pins (P86 to P80). If a port 8 read is performed while P8DDR bits are set to 1, the P8DR values are read directly, regardless of the actual pin states. If a port 8 read is performed while P8DDR bits are cleared to 0, the pin states are read.

P8DR is initialized to H'80 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.9.3 Pin Functions

Port 8 pins also function as SCI1 I/O pins (TxD1, RxD1, SCK1), the IIC1 I/O pin (SCL1), HIF I/O pins (CS $\bar{2}$, GA20, HA0, HIFSD), and external interrupt input pins ($\bar{I}RQ\bar{5}$ to $\bar{I}RQ\bar{3}$). The port 8 pin functions are shown in table 8.18.

Table 8.18 Port 8 Pin Functions

| Pin | Selection Method and Pin Functions | | | | | |
|--|---|-------------------|--------------------|--------------------|-------------------|-----------------|
| P86/ $\overline{\text{IRQ5}}$ /SCK1/ SCL1 | The pin function is switched as shown below according to the combination of bits CKE1 and CKE0 in SCR of SCI1, bit $\overline{\text{C/A}}$ in SMR of SCI1, bit ICE in ICCR of IIC1, and bit P86DDR. | | | | | |
| ICE | 0 | | | | | 1 |
| CKE1 | 0 | | | 1 | | 0 |
| $\overline{\text{C/A}}$ | 0 | | 1 | — | 0 | |
| CKE0 | 0 | | 1 | — | — | 0 |
| P86DDR | 0 | 1 | — | — | — | — |
| Pin function | P86 input pin | P86 output pin | SCK1 output pin | SCK1 output pin | SCK1 input pin | SCL1 I/O pin |
| | $\overline{\text{IRQ5}}$ input pin | | | | | |
| When the IRQ5E bit in IER is set to 1, this pin is used as the $\overline{\text{IRQ5}}$ input pin. When this pin is used as the SCL1 I/O pin, bits CKE1 and CKE0 in SCR of SCI1 and bit $\overline{\text{C/A}}$ in SMR of SCI1 must all be cleared to 0. SCL1 is an NMOS-only output, and has direct bus drive capability. | | | | | | |
| P85/ $\overline{\text{IRQ4}}$ /RxD1 | The pin function is switched as shown below according to the combination of bit RE in SCR of SCI1 and bit P85DDR. | | | | | |
| RE | 0 | | | 1 | | |
| P85DDR | 0 | | 1 | | — | |
| Pin function | P85 input pin | | P85 output pin | | RxD1 input pin | |
| | $\overline{\text{IRQ4}}$ input pin | | | | | |
| When the IRQ4E bit in IER is set to 1, this pin is used as the $\overline{\text{IRQ4}}$ input pin. | | | | | | |
| P84/ $\overline{\text{IRQ3}}$ /TxD1 | The pin function is switched as shown below according to the combination of bit TE in SCR of SCI1 and bit P84DDR. | | | | | |
| TE | 0 | | | 1 | | |
| P84DDR | 0 | | 1 | | — | |
| Pin function | P84 input pin | | P84 output pin | | TxD1 output pin | |
| | $\overline{\text{IRQ3}}$ input pin | | | | | |
| When the IRQ3E bit in IER is set to 1, this pin is used as the $\overline{\text{IRQ3}}$ input pin. | | | | | | |

Pin Selection Method and Pin Functions

P83 The pin function is switched as shown below according to bit P83DDR.

| | | |
|--------------|---------------|----------------|
| P83DDR | 0 | 1 |
| Pin function | P83 input pin | P83 output pin |

P82/HIFSD The pin function is switched as shown below according to the combination of operating mode, bit SDE in SYSCR2 of the HIF, and bit P82DDR.

| | | | | | |
|----------------|----------------|----------------|---------------|----------------|-----------------|
| Operating mode | Not slave mode | | Slave mode | | |
| SDE | — | | 0 | 1 | — |
| P82DDR | 0 | 1 | 0 | 1 | — |
| Pin function | P82 input pin | P82 output pin | P82 input pin | P82 output pin | HIFSD input pin |

P81/GA20/CS $\bar{2}$ The pin function is switched as shown below according to the combination of operating mode, bit CS2E, bit FGA20E in HICR of the HIF, and bit P81DDR.

| | | | | | | | |
|----------------|----------------|----------------|---------------|----------------|-----------------------------------|---------------|-----------------|
| Operating mode | Not slave mode | | Slave mode | | | | |
| FGA20E | — | | 0 | | 1 | | |
| CS2E | — | | 0 | 1 | — | | |
| P81DDR | 0 | 1 | 0 | 1 | — | 0 | 1 |
| Pin function | P81 input pin | P81 output pin | P81 input pin | P81 output pin | $\overline{\text{CS2}}$ input pin | P81 input pin | GA20 output pin |

This pin should be used as the GA20 or $\overline{\text{CS2}}$ output pin only in mode 2 or 3 (EXPE = 0).

P80/HA0 The pin function is switched as shown below according to the combination of operating mode and bit P80DDR.

| | | | |
|----------------|----------------|----------------|---------------|
| Operating mode | Not slave mode | | Slave mode |
| P80DDR | 0 | 1 | — |
| Pin function | P80 input pin | P80 output pin | HA0 input pin |

8.10 Port 9

8.10.1 Overview

Port 9 is an 8-bit I/O port. Port 9 pins also function as external interrupt input pins ($\overline{\text{IRQ0}}$ to $\overline{\text{IRQ2}}$), the A/D converter external trigger input pin ($\overline{\text{ADTRG}}$), host interface input pins ($\overline{\text{ECS2}}$, $\overline{\text{CS1}}$, $\overline{\text{IOW}}$, $\overline{\text{IOR}}$) (H8S/2138 Group only), the IIC0 I/O pin (SDA0) (option in H8S/2138 Group only), the subclock input pin (EXCL), bus control signal I/O pins ($\overline{\text{AS/IOS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{WAIT}}$), and the system clock (ϕ) output pin. In the H8S/2138 Group, P97 is an NMOS push-pull output. SDA0 is an NMOS open-drain output, and has direct bus drive capability.

Figure 8.17 shows the port 9 pin configuration.

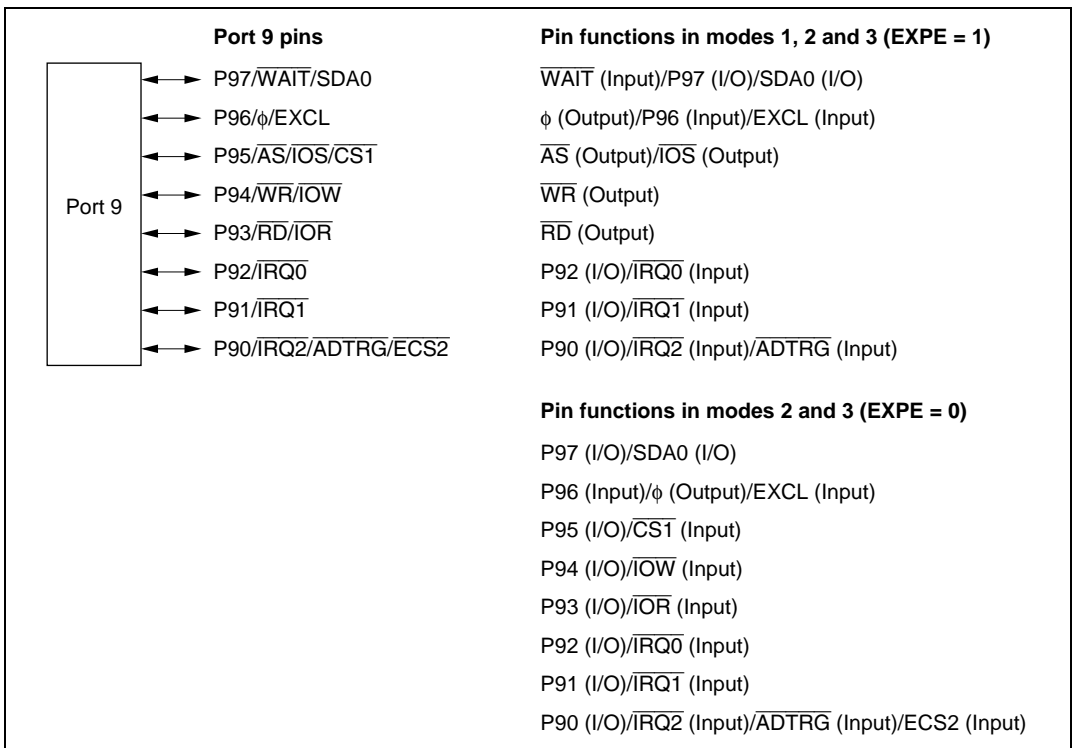


Figure 8.17 Port 9 Pin Functions

8.10.2 Register Configuration

Table 8.19 summarizes the port 9 registers.

Table 8.19 Port 9 Registers

| Name | Abbreviation | R/W | Initial Value | Address* ¹ |
|--------------------------------|--------------|-----|-------------------------|-----------------------|
| Port 9 data direction register | P9DDR | W | H'40/H'00* ² | H'FFC0 |
| Port 9 data register | P9DR | R/W | H'00 | H'FFC1 |

Notes: 1. Lower 16 bits of the address.
2. Initial value depends on the mode.

Port 9 Data Direction Register (P9DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P97DDR | P96DDR | P95DDR | P94DDR | P93DDR | P92DDR | P91DDR | P90DDR |
| Mode 1 | | | | | | | | |
| Initial value | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |
| Modes 2 and 3 | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P9DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 9. P9DDR cannot be read; if it is, an undefined value will be returned.

P9DDR is initialized to H'40 (mode 1) or H'00 (modes 2 and 3) by a reset and in hardware standby mode. It retains its prior state in software standby mode.

- Modes 1, 2, and 3 (EXPE = 1)

Pin P97 functions as a bus control input ($\overline{\text{WAIT}}$), the IIC0 I/O pin (SDA0), or an I/O port, according to the wait mode setting. When P97 functions as an I/O port, it becomes an output port when P97DDR is set to 1, and an input port when P97DDR is cleared to 0.

Pin P96 functions as the ϕ output pin when P96DDR is set to 1, and as the subclock input (EXCL) or an input port when P96DDR is cleared to 0.

Pins P95 to P93 automatically become bus control outputs ($\overline{\text{AS}}/\overline{\text{IOS}}$, $\overline{\text{WR}}$, $\overline{\text{RD}}$), regardless of the input/output direction indicated by P95DDR to P93DDR.

Pins P92 and P90 become output ports when P92DDR and P90DDR are set to 1, and input ports when P92DDR and P91DDR are cleared to 0.

- Modes 2 and 3 (EXPE = 0)

When the corresponding P9DDR bits are set to 1, pin P96 functions as the ϕ output pin and pins P97 and P95 to P90 become output ports. When P9DDR bits are cleared to 0, the corresponding pins become input ports.

Port 9 Data Register (P9DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P97DR | P96DR | P95DR | P94DR | P93DR | P92DR | P91DR | P90DR |
| Initial value | 0 | —* | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Determined by the state of pin P96.

P9DR is an 8-bit readable/writable register that stores output data for the port 9 pins (P97 to P90). With the exception of P96, if a port 9 read is performed while P9DDR bits are set to 1, the P9DR values are read directly, regardless of the actual pin states. If a port 9 read is performed while P9DDR bits are cleared to 0, the pin states are read.

P9DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.10.3 Pin Functions

Port 9 pins also function as external interrupt input pins ($\overline{\text{IRQ0}}$ to $\overline{\text{IRQ2}}$), the A/D converter trigger input pin ($\overline{\text{ADTRG}}$), HIF input pins ($\overline{\text{ECS2}}$, $\overline{\text{CS1}}$, $\overline{\text{IOW}}$, $\overline{\text{IOR}}$), the IIC0 I/O pin ($\overline{\text{SDA0}}$), the subclock input pin ($\overline{\text{EXCL}}$), bus control signal I/O pins ($\overline{\text{AS/IOS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{WAIT}}$), and the system clock (ϕ) output pin. The pin functions differ between the mode 1, 2, and 3 (EXPE = 1) expanded modes and the mode 2 and 3 (EXPE = 0) single-chip modes. The port 9 pin functions are shown in table 8.20.

Table 8.20 Port 9 Pin Functions**Pin Selection Method and Pin Functions**

P97/ $\overline{\text{WAIT}}$ /SDA0 The pin function is switched as shown below according to the combination of operating mode, bit WMS1 in WSCR, bit ICE in ICCR of IIC0, and bit P97DDR.

| Operating mode | Modes 1, 2, 3 (EXPE = 1) | | | | Modes 2, 3 (EXPE = 0) | | | |
|----------------|--------------------------|----------------|--------------|------------------------------------|-----------------------|----------------|--------------|---|
| WMS1 | 0 | | 1 | | — | | | |
| ICE | 0 | | 1 | — | 0 | | 1 | |
| P97DDR | 0 | 1 | — | | — | 0 | 1 | — |
| Pin function | P97 input pin | P97 output pin | SDA0 I/O pin | $\overline{\text{WAIT}}$ input pin | P97 input pin | P97 output pin | SDA0 I/O pin | |

In the H8S/2138 Group, when this pin is set as the P97 output pin, it is an NMOS push-pull output. SDA0 is an NMOS open-drain output, and has direct bus drive capability.

P96/ ϕ /EXCL The pin function is switched as shown below according to the combination of bit EXCLE in LPWRCR and bit P96DDR.

| P96DDR | 0 | | 1 | |
|--------------|---------------|--|----------------|-------------------|
| EXCLE | 0 | | 1 | 0 |
| Pin function | P96 input pin | | EXCL input pin | ϕ output pin |

When this pin is used as the EXCL input pin, P96DDR should be cleared to 0.

P95/ $\overline{\text{AS}}$ / $\overline{\text{IOS}}$ / $\overline{\text{CS1}}$ The pin function is switched as shown below according to the combination of operating mode, bit IOSE in SYSCR, bit HI12E in SYSCR2, and bit P95DDR.

| Operating mode | Modes 1, 2, 3 (EXPE = 1) | | Modes 2, 3 (EXPE = 0) | | |
|----------------|-----------------------------------|------------------------------------|-----------------------|----------------|-----------------------------------|
| HI12E | — | | 0 | | 1 |
| P95DDR | — | | 0 | 1 | — |
| IOSE | 0 | 1 | — | — | — |
| Pin function | $\overline{\text{AS}}$ output pin | $\overline{\text{IOS}}$ output pin | P95 input pin | P95 output pin | $\overline{\text{CS1}}$ input pin |

Pin Selection Method and Pin Functions**P94/ \overline{WR} / \overline{IOW}**

The pin function is switched as shown below according to the combination of operating mode, bit HI12E in SYSCR2, and bit P94DDR.

| Operating mode | Modes 1, 2, 3 (EXPE = 1) | Modes 2, 3 (EXPE = 0) | | |
|----------------|-------------------------------|-----------------------|-------------------|-------------------------------|
| | | 0 | | 1 |
| HI12E | — | 0 | | 1 |
| P94DDR | — | 0 | 1 | — |
| Pin function | \overline{WR} output pin | P94 input pin | P94 output pin | \overline{IOW} input pin |

P93/ \overline{RD} / \overline{IOR}

The pin function is switched as shown below according to the combination of operating mode, bit HI12E in SYSCR2, and bit P93DDR.

| Operating mode | Modes 1, 2, 3 (EXPE = 1) | Modes 2, 3 (EXPE = 0) | | |
|----------------|-----------------------------|-----------------------|----------------|----------------------------|
| | | 0 | | 1 |
| HI12E | — | 0 | | 1 |
| P93DDR | — | 0 | 1 | — |
| Pin function | \overline{RD} output pin | P93 input pin | P93 output pin | \overline{IOR} input pin |

P92/ $\overline{IRQ0}$

| P92DDR | 0 | 1 |
|--------------|-----------------------------|----------------|
| Pin function | P92 input pin | P92 output pin |
| | $\overline{IRQ0}$ input pin | |

When bit IRQ0E in IER is set to 1, this pin is used as the $\overline{IRQ0}$ input pin.

P91/ $\overline{IRQ1}$

| P91DDR | 0 | 1 |
|--------------|-----------------------------|----------------|
| Pin function | P91 input pin | P91 output pin |
| | $\overline{IRQ1}$ input pin | |

When bit IRQ1E in IER is set to 1, this pin is used as the $\overline{IRQ1}$ input pin.

Pin Selection Method and Pin Functions

P90/ $\overline{\text{IRQ2}}$ /
ADTRG/ $\overline{\text{ECS2}}$

The pin function is switched as shown below according to the combination of operating mode, bits HI12E and CS2E in SYSCR2, bit FGA20E in HICR, and bit P90DDR.

| Operating mode | Modes 1, 2, 3 (EXPE = 1) | | Modes 2, 3 (EXPE = 0) | | |
|----------------|---|-------------------|--------------------------|-------------------|---------------------------------------|
| | 0 | 1 | 0 | 1 | |
| HI12E | — | | Any one 0 | | 1 |
| FGA20E | — | | | | 1 |
| CS2E | — | | | | 1 |
| P90DDR | 0 | 1 | 0 | 1 | — |
| Pin function | P90 input pin | P90 output pin | P90 input pin | P90 output pin | $\overline{\text{ECS2}}$ input pin |
| | $\overline{\text{IRQ2}}$ input pin, ADTRG input pin | | | | |

When the IRQ2E bit in IER is set to 1, this pin is used as the $\overline{\text{IRQ2}}$ input pin.

When TRGS1 and TRGS0 in ADCR of the A/D converter are both set to 1, this pin is used as the ADTRG input pin.

Section 9 8-Bit PWM Timers [H8S/2138 Group]

9.1 Overview

The H8/2138 Group has an on-chip pulse width modulation (PWM) timer module with sixteen outputs. Sixteen output waveforms are generated from a common time base, enabling PWM output with a high carrier frequency to be produced using pulse division. The PWM timer module has sixteen 8-bit PWM data registers (PWDRs), and an output pulse with a duty cycle of 0 to 100% can be obtained as specified by PWDR and the port data register (P1DR or P2DR).

9.1.1 Features

The PWM timer module has the following features.

- Operable at a maximum carrier frequency of 1.25 MHz using pulse division (at 20-MHz operation)
- Duty cycles from 0 to 100% with 1/256 resolution (100% duty realized by port output)
- Direct or inverted PWM output, and PWM output enable/disable control

9.1.2 Block Diagram

Figure 9.1 shows a block diagram of the PWM timer module.

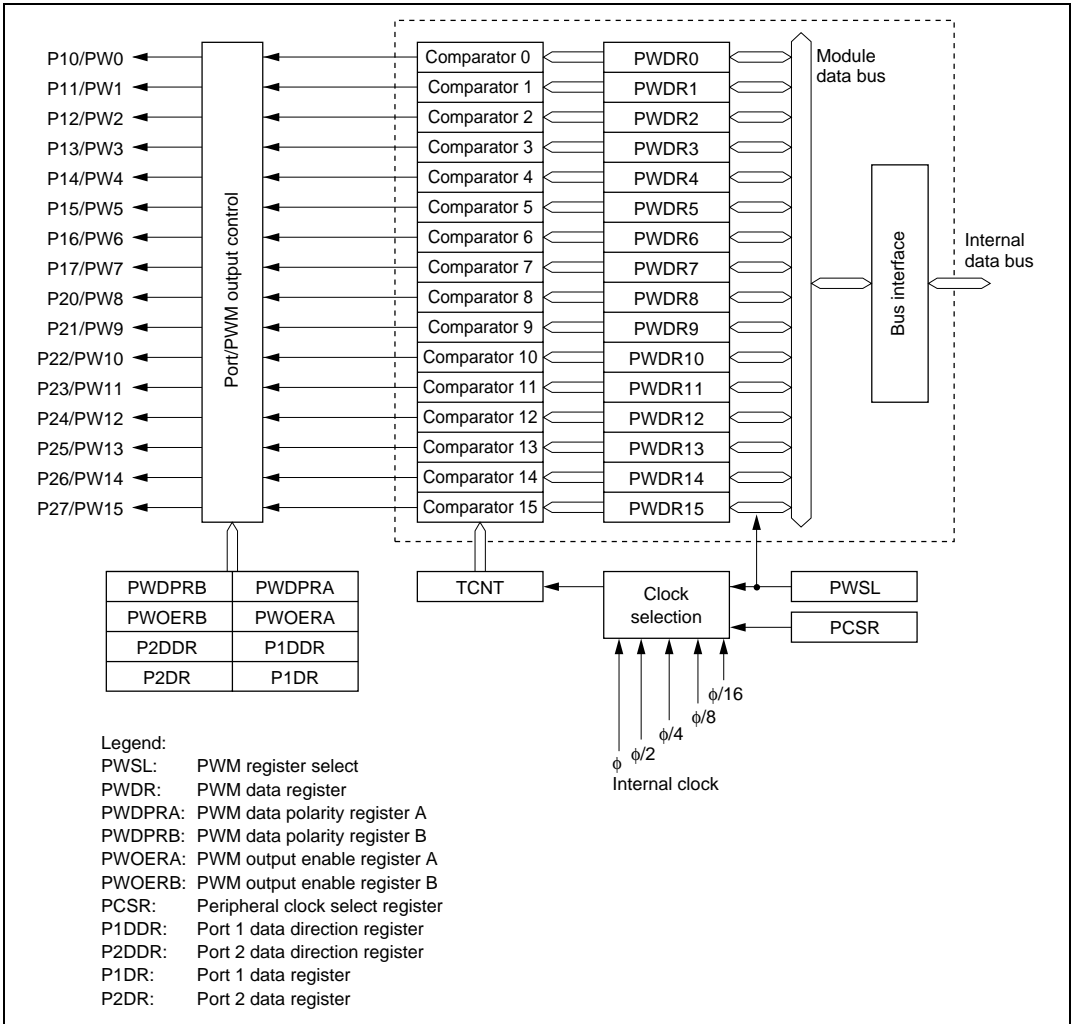


Figure 9.1 Block Diagram of PWM Timer Module

9.1.3 Pin Configuration

Table 9.1 shows the PWM output pin.

Table 9.1 Pin Configuration

| Name | Abbreviation | I/O | Function |
|------------------------|--------------|--------|--------------------------------|
| PWM output pin 0 to 15 | PW0 to PW15 | Output | PWM timer pulse output 0 to 15 |

9.1.4 Register Configuration

Table 9.2 lists the registers of the PWM timer module.

Table 9.2 PWM Timer Module Registers

| Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|----------------------------------|--------------------|-----|---------------|-----------------------|
| PWM register select | PWSL | R/W | H'20 | H'FFD6 |
| PWM data registers 0 to 15 | PWDR0 to PWDR15 | R/W | H'00 | H'FFD7 |
| PWM data polarity register A | PWDpra | R/W | H'00 | H'FFD5 |
| PWM data polarity register B | PWDprb | R/W | H'00 | H'FFD4 |
| PWM output enable register A | PWOera | R/W | H'00 | H'FFD3 |
| PWM output enable register B | PWOerb | R/W | H'00 | H'FFD2 |
| Port 1 data direction register | P1DDR | W | H'00 | H'FFB0 |
| Port 2 data direction register | P2DDR | W | H'00 | H'FFB1 |
| Port 1 data register | P1DR | R/W | H'00 | H'FFB2 |
| Port 2 data register | P2DR | R/W | H'00 | H'FFB3 |
| Peripheral clock select register | PCSR | R/W | H'00 | H'FF82 ^{*2} |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | MSTPCRL | R/W | H'FF | H'FF87 |

Notes: 1. Lower 16 bits of the address.

2. Some registers in the 8-bit timer are assigned in the same addresses as other registers. In this case, register selection is performed by the FLSHE bit in the serial timer control register (STCR).

9.2 Register Descriptions

9.2.1 PWM Register Select (PWSL)

| | | | | | | | | |
|---------------|-------|-------|---|---|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | PWCKE | PWCKS | — | — | RS3 | RS2 | RS1 | RS0 |
| Initial value | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | — | — | R/W | R/W | R/W | R/W |

PWSL is an 8-bit readable/writable register used to select the PWM timer input clock and the PWM data register.

PWSL is initialized to H'20 by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 7 and 6—PWM Clock Enable, PWM Clock Select (PWCKE, PWCKS): These bits, together with bits PWCKA and PWCKB in PCSR, select the internal clock input to TCNT in the PWM timer.

| PWSL | | PCSR | | Description |
|-------|-------|-------|-------|---|
| Bit 7 | Bit 6 | Bit 2 | Bit 1 | |
| PWCKE | PWCKS | PWCKB | PWCKA | |
| 0 | — | — | — | Clock input is disabled (Initial value) |
| 1 | 0 | — | — | ϕ (system clock) is selected |
| | 1 | 0 | 0 | $\phi/2$ is selected |
| | | | 1 | $\phi/4$ is selected |
| | | 1 | 0 | $\phi/8$ is selected |
| | | | 1 | $\phi/16$ is selected |

The PWM resolution, PWM conversion period, and carrier frequency depend on the selected internal clock, and can be found from the following equations.

$$\text{Resolution (minimum pulse width)} = 1/\text{internal clock frequency}$$

$$\text{PWM conversion period} = \text{resolution} \times 256$$

$$\text{Carrier frequency} = 16/\text{PWM conversion period}$$

Thus, with a 20-MHz system clock (ϕ), the resolution, PWM conversion period, and carrier frequency are as shown below.

Table 9.3 Resolution, PWM Conversion Period, and Carrier Frequency when $\phi = 20$ MHz

| Internal Clock Frequency | Resolution | PWM Conversion Period | Carrier Frequency |
|--------------------------|------------|-----------------------|-------------------|
| ϕ | 50 ns | 12.8 μ s | 1250 kHz |
| $\phi/2$ | 100 ns | 25.6 μ s | 625 kHz |
| $\phi/4$ | 200 ns | 51.2 μ s | 312.5 kHz |
| $\phi/8$ | 400 ns | 102.4 μ s | 156.3 kHz |
| $\phi/16$ | 800 ns | 204.8 μ s | 78.1 kHz |

Bit 5—Reserved: This bit is always read as 1 and cannot be modified.

Bit 4—Reserved: This bit is always read as 0 and cannot be modified.

Bits 3 to 0—Register Select (RS3 to RS0): These bits select the PWM data register.

| Bit 3 | Bit 2 | Bit 1 | Bit 0 | Register Selection |
|-------|-------|-------|-------|--------------------|
| RS3 | RS2 | RS1 | RS0 | |
| 0 | 0 | 0 | 0 | PWDR0 selected |
| | | | 1 | PWDR1 selected |
| | | 1 | 0 | PWDR2 selected |
| | | | 1 | PWDR3 selected |
| | 1 | 0 | 0 | PWDR4 selected |
| | | | 1 | PWDR5 selected |
| | | 1 | 0 | PWDR6 selected |
| | | | 1 | PWDR7 selected |
| 1 | 0 | 0 | 0 | PWDR8 selected |
| | | | 1 | PWDR9 selected |
| | | 1 | 0 | PWDR10 selected |
| | | | 1 | PWDR11 selected |
| | 1 | 0 | 0 | PWDR12 selected |
| | | | 1 | PWDR13 selected |
| | | 1 | 0 | PWDR14 selected |
| | | | 1 | PWDR15 selected |

9.2.2 PWM Data Registers (PWDR0 to PWDR15)

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Each PWDR is an 8-bit readable/writable register that specifies the duty cycle of the basic pulse to be output, and the number of additional pulses. The value set in PWDR corresponds to a 0 or 1 ratio in the conversion period. The upper 4 bits specify the duty cycle of the basic pulse as 0/16 to 15/16 with a resolution of 1/16. The lower 4 bits specify how many extra pulses are to be added within the conversion period comprising 16 basic pulses. Thus, a specification of 0/256 to 255/256 is possible for 0/1 ratios within the conversion period. For 256/256 (100%) output, port output should be used.

PWDR is initialized to H'00 by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

9.2.3 PWM Data Polarity Registers A and B (PWDPRA and PWDPRB)

PWDPRA

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | OS7 | OS6 | OS5 | OS4 | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PWDPRB

| | | | | | | | | |
|---------------|------|------|------|------|------|------|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | OS15 | OS14 | OS13 | OS12 | OS11 | OS10 | OS9 | OS8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Each PWDPR is an 8-bit readable/writable register that controls the polarity of the PWM output. Bits OS0 to OS15 correspond to outputs PW0 to PW15.

PWDPR is initialized to H'00 by a reset and in hardware standby mode.

| OS | Description |
|----|--|
| 0 | PWM direct output (PWDR value corresponds to high width of output) (Initial value) |
| 1 | PWM inverted output (PWDR value corresponds to low width of output) |

9.2.4 PWM Output Enable Registers A and B (PWOERA and PWOERB)

PWOERA

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| | OE7 | OE6 | OE5 | OE4 | OE3 | OE2 | OE1 | OE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PWOERB

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|-----|-----|
| | OE15 | OE14 | OE13 | OE12 | OE11 | OE10 | OE9 | OE8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Each PWOER is an 8-bit readable/writable register that switches between PWM output and port output. Bits OE15 to OE0 correspond to outputs PW15 to PW0. To set a pin in the output state, a setting in the port direction register is also necessary. Bits P17DDR to P10DDR correspond to outputs PW7 to PW0, and bits P27DDR to P20DDR correspond to outputs PW15 to PW8.

PWOER is initialized to H'00 by a reset and in hardware standby mode.

| DDR | OE | Description |
|-----|----|-----------------------------------|
| 0 | 0 | Port input (Initial value) |
| | 1 | Port input |
| 1 | 0 | Port output or PWM 256/256 output |
| | 1 | PWM output (0 to 255/256 output) |

9.2.5 Peripheral Clock Select Register (PCSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-------|-------|---|
| | — | — | — | — | — | PWCKB | PWCKA | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | R/W | R/W | — |

PCSR is an 8-bit readable/writable register that selects the PWM timer input clock.

PCSR is initialized to H'00 by a reset, and in hardware standby mode.

Bits 7 to 3—Reserved: These bits cannot be modified and are always read as 0.

Bits 2 and 1—PWM Clock Select (PWCKB, PWCKA): Together with bits PWCKE and PWCKS in PWSL, these bits select the internal clock input to TCNT in the PWM timer. For details, see section 9.2.1, PWM Register Select (PWSL).

Bit 0—Reserved: Do not set this bit to 1.

9.2.6 Port 1 Data Direction Register (P1DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P17DDR | P16DDR | P15DDR | P14DDR | P13DDR | P12DDR | P11DDR | P10DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P1DDR is an 8-bit write-only register that specifies the input/output direction and PWM output for each pin of port 1 on a bit-by-bit basis.

Port 1 pins are multiplexed with pins PW0 to PW7. The bit corresponding to a pin to be used for PWM output should be set to 1.

For details on P1DDR, see section 8.2, Port 1.

9.2.7 Port 2 Data Direction Register (P2DDR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P27DDR | P26DDR | P25DDR | P24DDR | P23DDR | P22DDR | P21DDR | P20DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

P2DDR is an 8-bit write-only register that specifies the input/output direction and PWM output for each pin of port J on a bit-by-bit basis.

Port 2 pins are multiplexed with pins PW8 to PW15. The bit corresponding to a pin to be used for PWM output should be set to 1.

For details on P2DDR, see section 8.3, Port 2.

9.2.8 Port 1 Data Register (P1DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P17DR | P16DR | P15DR | P14DR | P13DR | P12DR | P11DR | P10DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P1DR is an 8-bit readable/writable register used to fix PWM output at 1 (when OS = 0) or 0 (when OS = 1).

For details on P1DR, see section 8.2, Port 1.

9.2.9 Port 2 Data Register (P2DR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P27DR | P26DR | P25DR | P24DR | P23DR | P22DR | P21DR | P20DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

P2DR is an 8-bit readable/writable register used to fix PWM output at 1 (when OS = 0) or 0 (when OS = 1).

For details on P2DR, see section 8.3, Port 2.

9.2.10 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP11 bit is set to 1, 8-bit PWM timer operation is halted and a transition is made to module stop mode. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 3—Module Stop (MSTP11): Specifies PWM module stop mode.

MSTPCRH

Bit 3

| MSTP11 | Description |
|--------|---|
| 0 | PWM module stop mode is cleared |
| 1 | PWM module stop mode is set (Initial value) |

9.3 Operation

9.3.1 Correspondence between PWM Data Register Contents and Output Waveform

The upper 4 bits of PWDR specify the duty cycle of the basic pulse as 0/16 to 15/16 with a resolution of 1/16, as shown in table 9.4.

Table 9.4 Duty Cycle of Basic Pulse

| Upper 4 Bits | Basic Pulse Waveform (Internal) |
|--------------|-----------------------------------|
| 0000 | 0 1 2 3 4 5 6 7 8 9 A B C D E F 0 |
| 0001 | |
| 0010 | |
| 0011 | |
| 0100 | |
| 0101 | |
| 0110 | |
| 0111 | |
| ⋮ | |
| 1000 | |
| 1001 | |
| 1010 | |
| 1011 | |
| 1100 | |
| 1101 | |
| 1110 | |
| 1111 | |

The lower 4 bits of PWDR specify the position of pulses added to the 16 basic pulses, as shown in table 9.5. An additional pulse consists of a high period (when OS = 0) with a width equal to the resolution, added before the rising edge of a basic pulse. When the upper 4 bits of PWDR are 0000, there is no rising edge of the basic pulse, but the timing for adding pulses is the same.

Table 9.5 Position of Pulses Added to Basic Pulses

| Lower 4 Bits | Basic Pulse No. | | | | | | | | | | | | | | | |
|--------------|-----------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
| 0000 | | | | | | | | | | | | | | | | |
| 0001 | | | | | | | | | | | | | | | | Yes |
| 0010 | | | | | | | | Yes | | | | | | | | Yes |
| 0011 | | | | | | | | Yes | | | | Yes | | | | Yes |
| 0100 | | | | Yes | | | | Yes | | | | Yes | | | | Yes |
| 0101 | | | | Yes | | | | Yes | | | | Yes | | Yes | | Yes |
| 0110 | | | | Yes | | Yes | | Yes | | | | Yes | | Yes | | Yes |
| 0111 | | | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes |
| 1000 | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes |
| 1001 | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | Yes | Yes |
| 1010 | | Yes | | Yes | | Yes | Yes | Yes | | Yes | | Yes | | Yes | Yes | Yes |
| 1011 | | Yes | | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes |
| 1100 | | Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes |
| 1101 | | Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes | Yes | Yes | Yes | Yes |
| 1110 | | Yes | Yes | Yes | Yes | Yes | Yes | Yes | | Yes | Yes | Yes | Yes | Yes | Yes | Yes |
| 1111 | | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes |

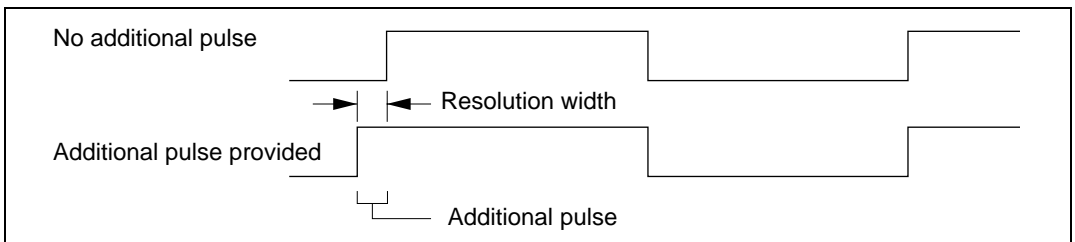


Figure 9.2 Example of Additional Pulse Timing (When Upper 4 Bits of PWDR = 1000)

Section 10 14-Bit PWM D/A

10.1 Overview

The H8S/2138 Group and H8S/2134 Group have an on-chip 14-bit pulse-width modulator (PWM) with two output channels.

Each channel can be connected to an external low-pass filter to operate as a 14-bit D/A converter.

Both channels share the same counter (DACNT) and control register (DACR).

10.1.1 Features

The features of the 14-bit PWM D/A are listed below.

- The pulse is subdivided into multiple base cycles to reduce ripple.
- Two resolution settings and two base cycle settings are available
The resolution can be set equal to one or two system clock cycles. The base cycle can be set equal to $T \times 64$ or $T \times 256$, where T is the resolution.
- Four operating rates
The two resolution settings and two base cycle settings combine to give a selection of four operating rates.

10.1.2 Block Diagram

Figure 10.1 shows a block diagram of the PWM D/A module.

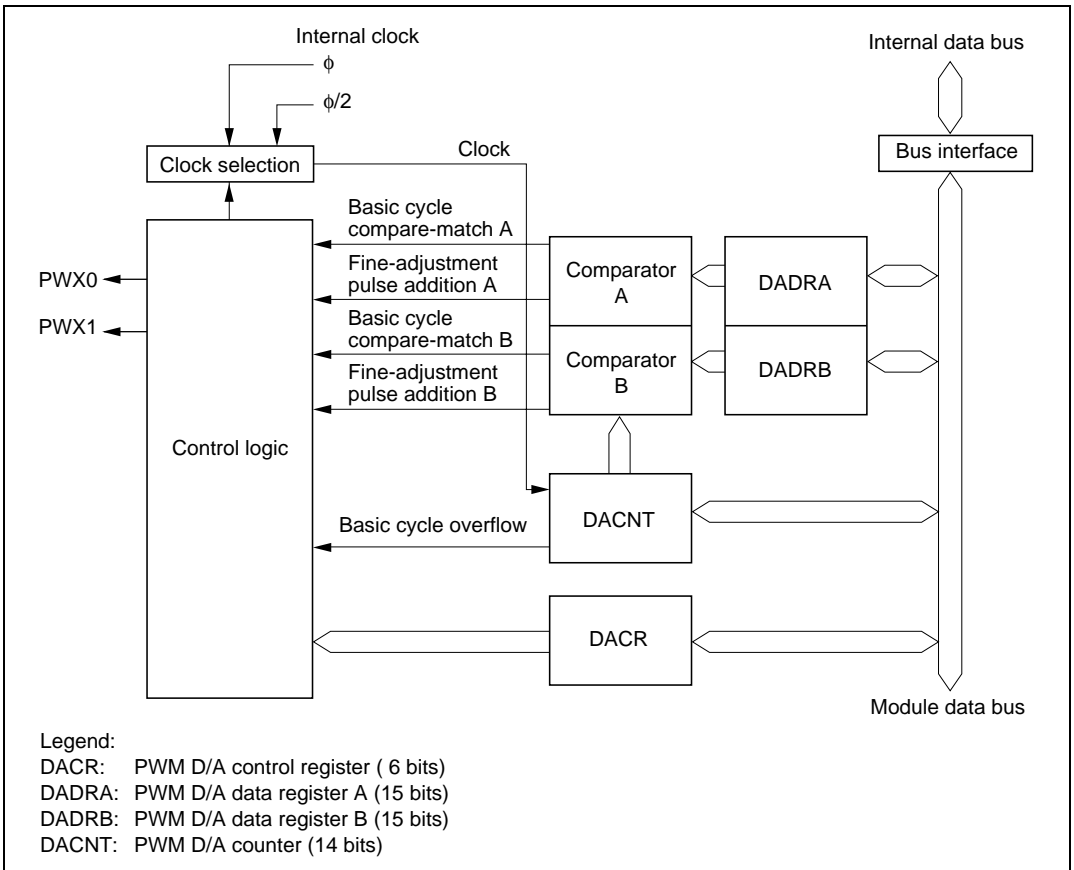


Figure 10.1 PWM D/A Block Diagram

10.1.3 Pin Configuration

Table 10.1 lists the pins used by the PWM D/A module.

Table 10.1 Input and Output Pins

| Name | Abbr. | I/O | Function |
|------------------|-------|--------|-----------------------|
| PWM output pin 0 | PWX0 | Output | PWM output, channel A |
| PWM output pin 1 | PWX1 | Output | PWM output, channel B |

10.1.4 Register Configuration

Table 10.2 lists the registers of the PWM D/A module.

Table 10.2 Register Configuration

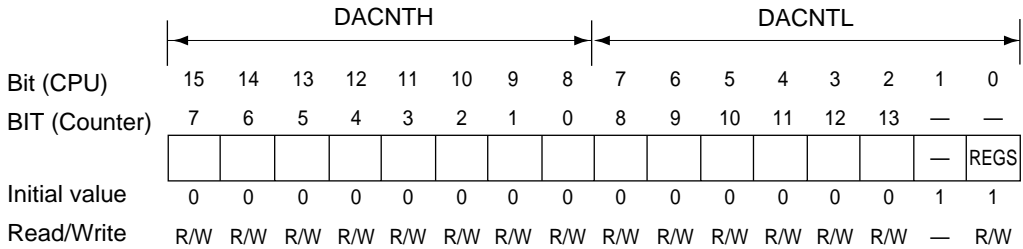
| Name | Abbreviation | R/W | Initial value | Address ^{*1} |
|------------------------------|--------------|-----|---------------|-----------------------|
| PWM D/A control register | DACR | R/W | H'30 | H'FFA0 ^{*2} |
| PWM D/A data register A high | DADRAH | R/W | H'FF | H'FFA0 ^{*2} |
| PWM D/A data register A low | DADRAL | R/W | H'FF | H'FFA1 ^{*2} |
| PWM D/A data register B high | DADRBH | R/W | H'FF | H'FFA6 ^{*2} |
| PWM D/A data register B low | DADRBL | R/W | H'FF | H'FFA7 ^{*2} |
| PWM D/A counter high | DACNTH | R/W | H'00 | H'FFA6 ^{*2} |
| PWM D/A counter low | DACNTL | R/W | H'03 | H'FFA7 ^{*2} |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | MSTPCRL | R/W | H'FF | H'FF87 |

Notes: 1. Lower 16 bits of the address.

2. Registers in the 14-bit PWM timer are assigned to the same addresses as the other registers. In this case, register selection is performed by the IICE bit in the serial timer control register (STCR), and also the same addresses are shared by DADRAH and DACR, and by DADRB and DACNT. Switching is performed by the REGS bit in DACNT or DADRB.

10.2 Register Descriptions

10.2.1 PWM D/A Counter (DACNT)



DACNT is a 14-bit readable/writable up-counter that increments on an input clock pulse. The input clock is selected by the clock select bit (CKS) in DACR. The CPU can read and write the DACNT value, but since DACNT is a 16-bit register, data transfers between it and the CPU are performed using a temporary register (TEMP). See section 10.3, Bus Master Interface, for details.

DACNT functions as the time base for both PWM D/A channels. When a channel operates with 14-bit precision, it uses all DACNT bits. When a channel operates with 12-bit precision, it uses the lower 12 (counter) bits and ignores the upper two (counter) bits.

DACNT is initialized to H'0003 by a reset, in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode, and by the PWME bit.

Bit 1 of DACNTL (CPU) is not used, and is always read as 1.

DACNTL Bit 0—Register Select (REGS): DADRA and DACR, and DADRb and DACNT, are located at the same addresses. The REGS bit specifies which registers can be accessed. The REGS bit can be accessed regardless of whether DADRb or DACNT is selected.

Bit 0

| REGS | Description |
|------|--|
| 0 | DADRA and DADRb can be accessed |
| 1 | DACR and DACNT can be accessed (Initial value) |

10.2.2 D/A Data Registers A and B (DADRA and DADRB)

| | DADRH | | | | | | | | DADRL | | | | | | | |
|---------------|-------|------|------|------|-----|-----|-----|-----|-------|-----|-----|-----|-----|-----|-----|------|
| Bit (CPU) | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Bit (Data) | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | — | — |
| DADRA | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | — |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | — |
| DADRB | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | REGS |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

There are two 16-bit readable/writable D/A data registers: DADRA and DADRB. DADRA corresponds to PWM D/A channel A, and DADRB to PWM D/A channel B. The CPU can read and write the PWM D/A data register values, but since DADRA and DADRB are 16-bit registers, data transfers between them and the CPU are performed using a temporary register (TEMP). See section 10.3, Bus Master Interface, for details.

The least significant (CPU) bit of DADRA is not used and is always read as 1.

DADR is initialized to H'FFFF by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 15 to 3—PWM D/A Data 13 to 0 (DA13 to DA0): The digital value to be converted to an analog value is set in the upper 14 bits of the PWM D/A data register.

In each base cycle, the DACNT value is continually compared with these upper 14 bits to determine the duty cycle of the output waveform, and to decide whether to output a fine-adjustment pulse equal in width to the resolution. To enable this operation, the data register must be set within a range that depends on the carrier frequency select bit (CFS). If the DADR value is outside this range, the PWM output is held constant.

A channel can be operated with 12-bit precision by keeping the two lowest data bits (DA0 and DA1) cleared to 0 and writing the data to be converted in the upper 12 bits. The two lowest data bits correspond to the two highest counter (DACNT) bits.

Bit 1—Carrier Frequency Select (CFS)

Bit 1

| CFS | Description |
|-----|--|
| 0 | Base cycle = resolution (T) × 64 DADR range = H'0401 to H'FFFD |
| 1 | Base cycle = resolution (T) × 256 DADR range = H'0103 to H'FFFF (Initial value) |

DADRA Bit 0—Reserved: This bit cannot be modified and is always read as 1.

DADRB Bit 0—Register Select (REGS): DADRA and DACR, and DADRB and DACNT, are located at the same addresses. The REGS bit specifies which registers can be accessed. The REGS bit can be accessed regardless of whether DADRB or DACNT is selected.

Bit 0

| REGS | Description |
|------|--|
| 0 | DADRA and DADRB can be accessed |
| 1 | DACR and DACNT can be accessed (Initial value) |

10.2.3 PWM D/A Control Register (DACR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|---|---|-----|-----|-----|-----|
| | TEST | PWME | — | — | OEB | OEA | OS | CKS |
| Initial value | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | — | — | R/W | R/W | R/W | R/W |

DACR is an 8-bit readable/writable register that selects test mode, enables the PWM outputs, and selects the output phase and operating speed.

DACR is initialized to H'30 by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Test Mode (TEST): Selects test mode, which is used in testing the chip. Normally this bit should be cleared to 0.

Bit 7

| TEST | Description |
|------|--|
| 0 | PWM (D/A) in user state: normal operation (Initial value) |
| 1 | PWM (D/A) in test state: correct conversion results unobtainable |

Bit 6—PWM Enable (PWME): Starts or stops the PWM D/A counter (DACNT).

Bit 6

| PWME | Description |
|------|---|
| 0 | DACNT operates as a 14-bit up-counter (Initial value) |
| 1 | DACNT halts at H'0003 |

Bits 5 and 4—Reserved: These bits cannot be modified and are always read as 1.

Bit 3—Output Enable B (OEB): Enables or disables output on PWM D/A channel B.

Bit 3

| OEB | Description |
|-----|--|
| 0 | PWM (D/A) channel B output (at the PWX1 pin) is disabled (Initial value) |
| 1 | PWM (D/A) channel B output (at the PWX1 pin) is enabled |

Bit 2—Output Enable A (OEA): Enables or disables output on PWM D/A channel A.

Bit 2

| OEA | Description | |
|-----|--|-----------------|
| 0 | PWM (D/A) channel A output (at the PWX0 pin) is disabled | (Initial value) |
| 1 | PWM (D/A) channel A output (at the PWX0 pin) is enabled | |

Bit 1—Output Select (OS): Selects the phase of the PWM D/A output.

Bit 1

| OS | Description | |
|----|---------------------|-----------------|
| 0 | Direct PWM output | (Initial value) |
| 1 | Inverted PWM output | |

Bit 0—Clock Select (CKS): Selects the PWM D/A resolution. If the system clock (ϕ) frequency is 10 MHz, resolutions of 100 ns and 200 ns can be selected.

Bit 0

| CKS | Description | |
|-----|---|-----------------|
| 0 | Operates at resolution (T) = system clock cycle time (t_{cyc}) | (Initial value) |
| 1 | Operates at resolution (T) = system clock cycle time (t_{cyc}) \times 2 | |

10.2.4 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|--------|--------|--------|--------|--------|-------|-------|---------|-------|-------|-------|-------|-------|-------|-------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | MSTP15 | MSTP14 | MSTP13 | MSTP12 | MSTP11 | MSTP10 | MSTP9 | MSTP8 | MSTP7 | MSTP6 | MSTP5 | MSTP4 | MSTP3 | MSTP2 | MSTP1 | MSTP0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP11 bit is set to 1, 14-bit PWM timer operation is halted and a transition is made to module stop mode. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 3—Module Stop (MSTP11): Specifies PWMX module stop mode.

MSTPCRH

Bit 3

| MSTP11 | Description |
|--------|--|
| 0 | PWMX module stop mode is cleared |
| 1 | PWMX module stop mode is set (Initial value) |

10.3 Bus Master Interface

DACNT, DADRA, and DADRB are 16-bit registers. The data bus linking the bus master and the on-chip supporting modules, however, is only 8 bits wide. When the bus master accesses these registers, it therefore uses an 8-bit temporary register (TEMP).

These registers are written and read as follows (taking the example of the CPU interface).

- Write

When the upper byte is written, the upper-byte write data is stored in TEMP. Next, when the lower byte is written, the lower-byte write data and TEMP value are combined, and the combined 16-bit value is written in the register.

- Read

When the upper byte is read, the upper-byte value is transferred to the CPU and the lower-byte value is transferred to TEMP. Next, when the lower byte is read, the lower-byte value in TEMP is transferred to the CPU.

These registers should always be accessed 16 bits at a time using an MOV instruction (by word access or two consecutive byte accesses), and the upper byte should always be accessed before the lower byte. Correct data will not be transferred if only the upper byte or only the lower byte is accessed. Also note that a bit manipulation instruction cannot be used to access these registers.

Figure 10.2 shows the data flow for access to DACNT. The other registers are accessed similarly.

Example 1: Write to DACNT

```
MOV.W R0, @DACNT ; Write R0 contents to DACNT
```

Example 2: Read DADRA

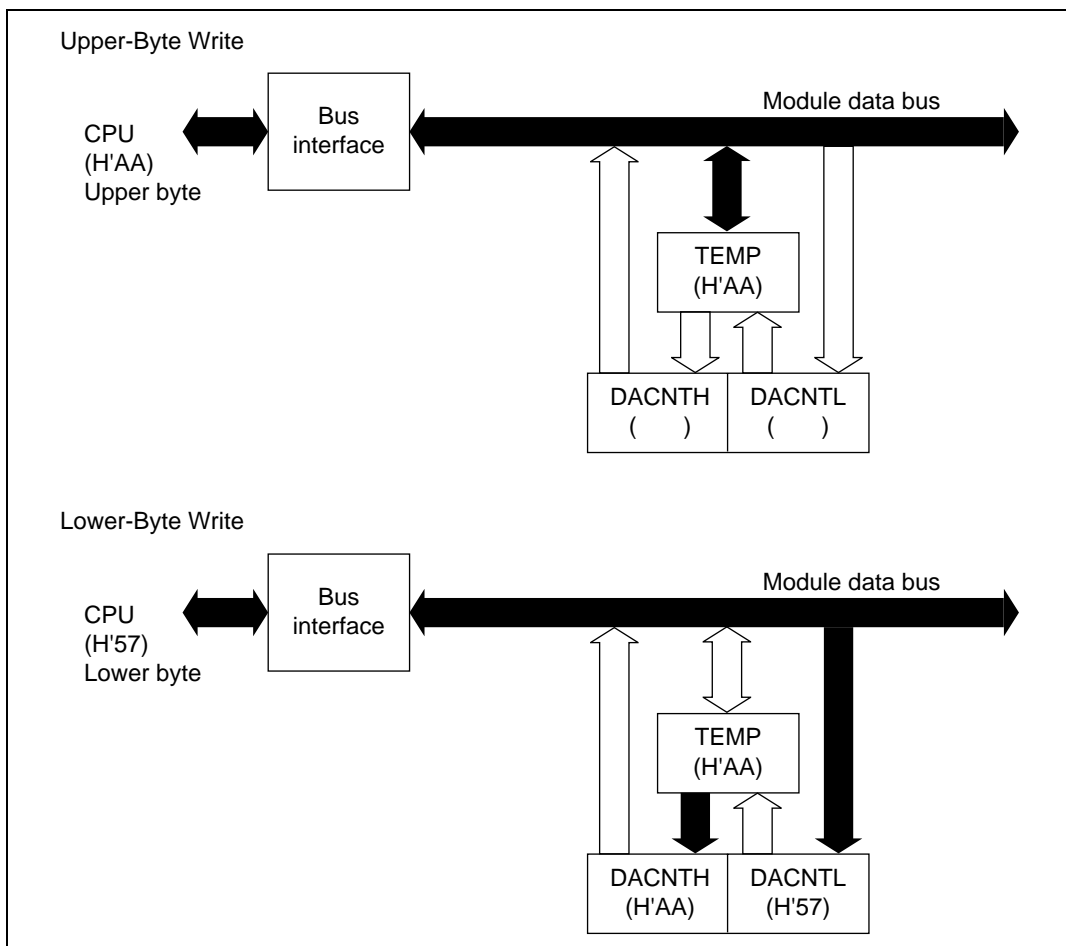
```
MOV.W @DADRA, R0 ; Copy contents of DADRA to R0
```

Table 10.3 Read and Write Access Methods for 16-Bit Registers

| Register Name | Read | | Write | |
|-----------------|------|------|-------|------|
| | Word | Byte | Word | Byte |
| DADRA and DADRB | Yes | Yes | Yes | × |
| DACNT | Yes | × | Yes | × |

Notes: Yes: Permitted type of access. Word access includes successive byte accesses to the upper byte (first) and lower byte (second).

×: This type of access may give incorrect results.

**Figure 10.2 (a) Access to DACNT (CPU Writes H'AA57 to DACNT)**

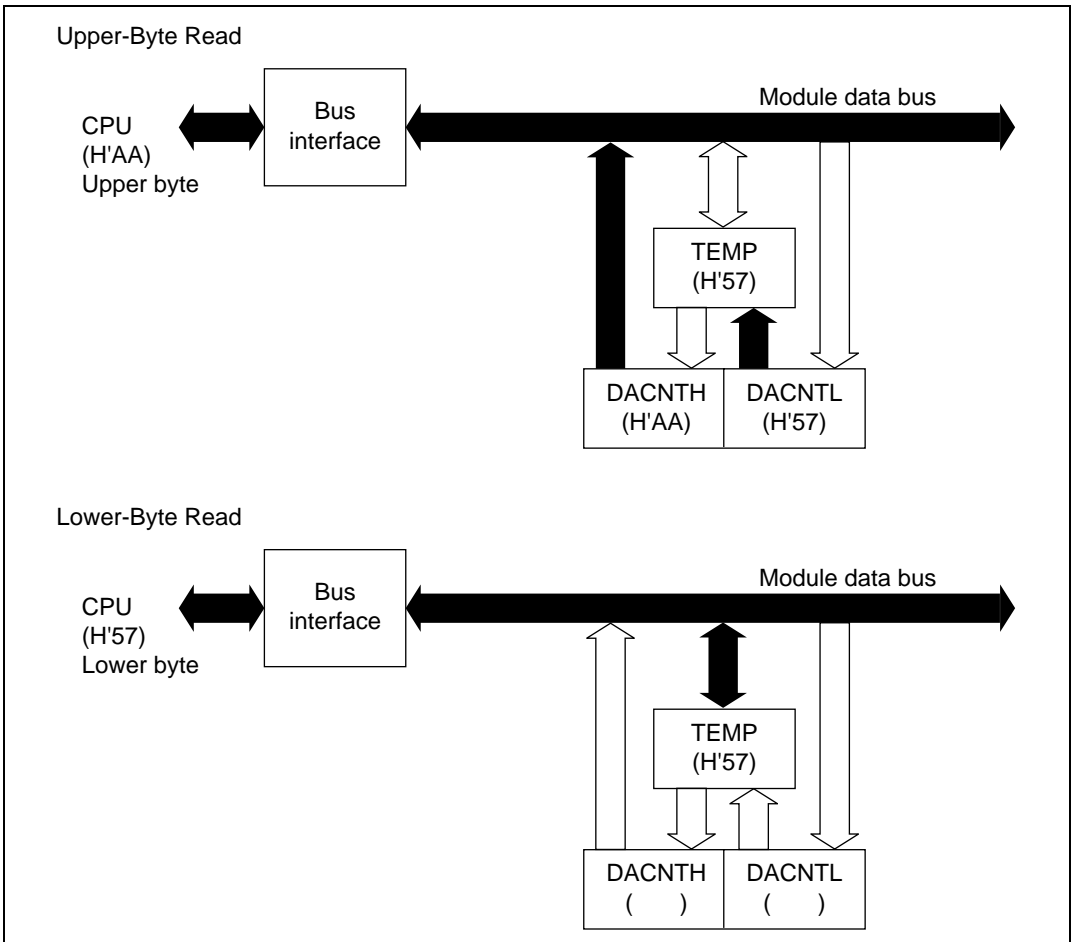


Figure 10.2 (b) Access to DACNT (CPU Reads H'AA57 from DACNT)

10.4 Operation

A PWM waveform like the one shown in figure 10.3 is output from the PWMX pin. When OS = 0, the value in DADR corresponds to the total width (T_L) of the low (0) pulses output in one conversion cycle (256 pulses when CFS = 0, 64 pulses when CFS = 1). When OS = 1, the output waveform is inverted and the DADR value corresponds to the total width (T_H) of the high (1) output pulses. Figure 10.4 shows the types of waveform output available.

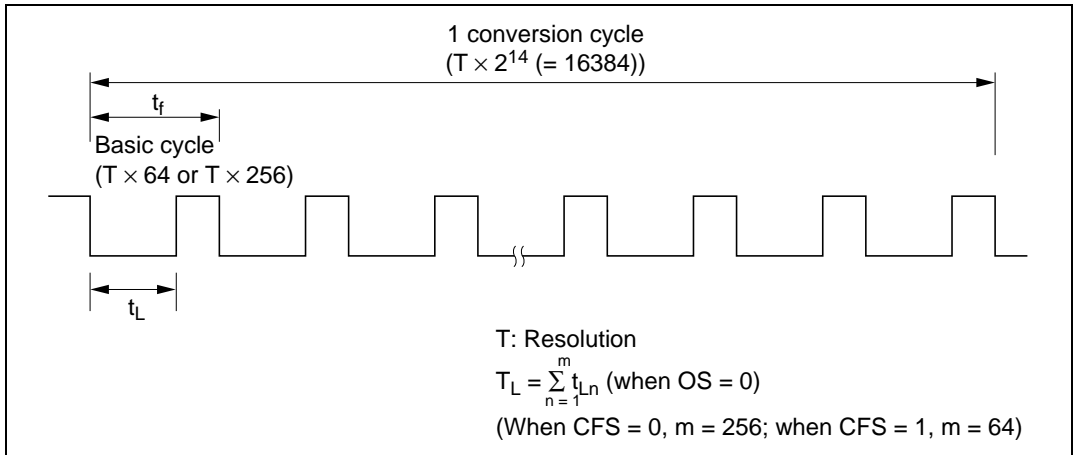


Figure 10.3 PWM D/A Operation

Table 10.4 summarizes the relationships of the CKS, CFS, and OS bit settings to the resolution, base cycle, and conversion cycle. The PWM output remains flat unless DADR contains at least a certain minimum value. Table 10.4 indicates the range of DADR settings that give an output waveform like the one in figure 10.3, and lists the conversion cycle length when low-order DADR bits are kept cleared to 0, reducing the conversion precision to 12 bits or 10 bits.

Table 10.4 Settings and Operation (Examples when $\phi = 10$ MHz)

| CKS | Resolution T (μ s) | CFS | Base Cycle (μ s) | Conversion Cycle (μ s) | T _L (if OS = 0) T _H (if OS = 1) | Fixed DADR Bits | | | | Conversion Cycle* (μ s) | |
|-----|----------------------------|-----|-----------------------------|-----------------------------------|---|---------------------|----------|---|---|------------------------------------|--------|
| | | | | | | Precision (Bits) | Bit Data | | | | |
| | | | | | | | 3 | 2 | 1 | | 0 |
| 0 | 0.1 | 0 | 6.4 | 1638.4 | 1. Always low (or high) (DADR = H'0001 to H'03FD) 2. (Data value) \times T (DADR = H'0401 to H'FFFF) | 14 | | | | | 1638.4 |
| | | | | | | 12 | | | 0 | 0 | 409.6 |
| | | | | | | 10 | 0 | 0 | 0 | 0 | 102.4 |
| | | 1 | 25.6 | 1638.4 | 1. Always low (or high) (DADR = H'0003 to H'00FF) 2. (Data value) \times T (DADR = H'0103 to H'FFFF) | 14 | | | | | 1638.4 |
| | | | | | | 12 | | | 0 | 0 | 409.6 |
| | | | | | | 10 | 0 | 0 | 0 | 0 | 102.4 |
| 1 | 0.2 | 0 | 12.8 | 3276.8 | 1. Always low (or high) (DADR = H'0001 to H'03FD) 2. (Data value) \times T (DADR = H'0401 to H'FFFF) | 14 | | | | | 3276.8 |
| | | | | | | 12 | | | 0 | 0 | 819.2 |
| | | | | | | 10 | 0 | 0 | 0 | 0 | 204.8 |
| | | 1 | 51.2 | 3276.8 | 1. Always low (or high) (DADR = H'0003 to H'00FF) 2. (Data value) \times T (DADR = H'0103 to H'FFFF) | 14 | | | | | 3276.8 |
| | | | | | | 12 | | | 0 | 0 | 819.2 |
| | | | | | | 10 | 0 | 0 | 0 | 0 | 204.8 |

Note: * This column indicates the conversion cycle when specific DADR bits are fixed.

1. OS = 0 (DADR corresponds to T_L)
 - a. CFS = 0 [base cycle = resolution (T) × 64]

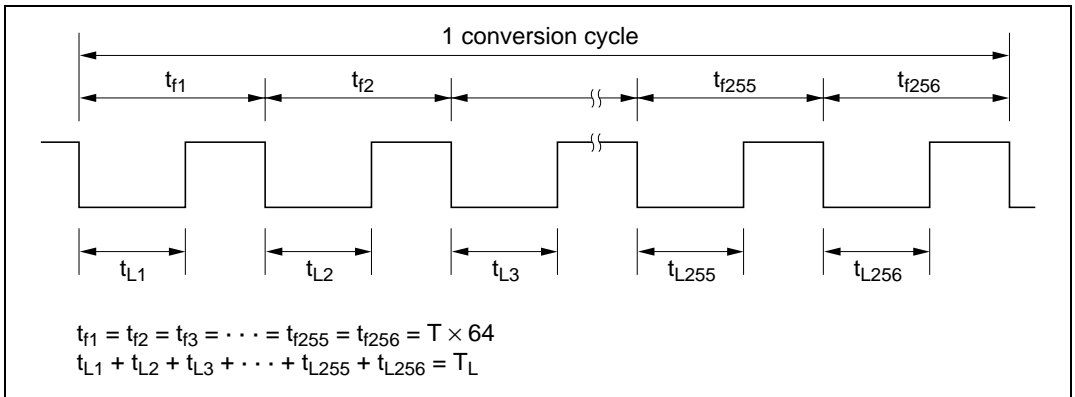


Figure 10.4 (1) Output Waveform

- b. CFS = 1 [base cycle = resolution (T) × 256]

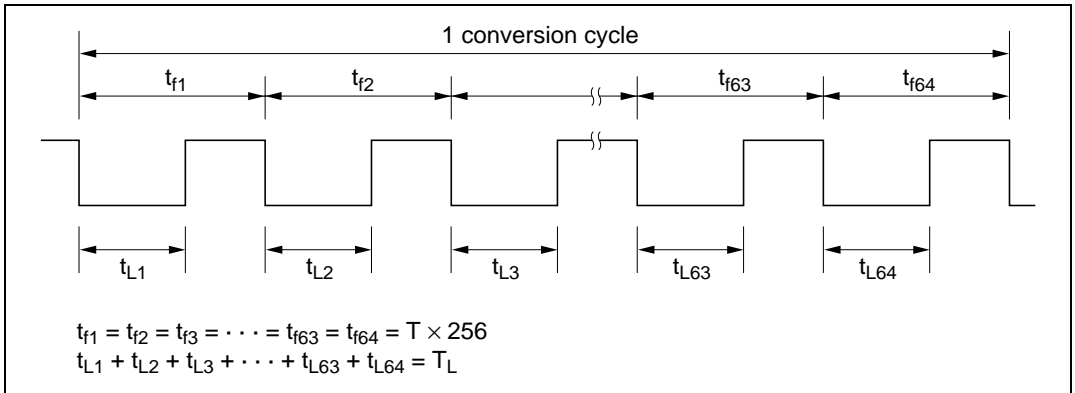


Figure 10.4 (2) Output Waveform

2. OS = 1 (DADR corresponds to T_H)

a. CFS = 0 [base cycle = resolution (T) \times 64]

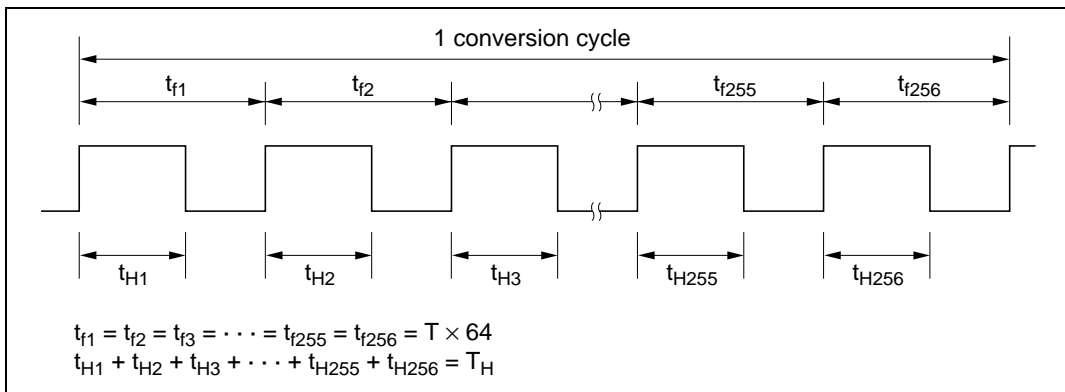


Figure 10.4 (3) Output Waveform

b. CFS = 1 [base cycle = resolution (T) \times 256]

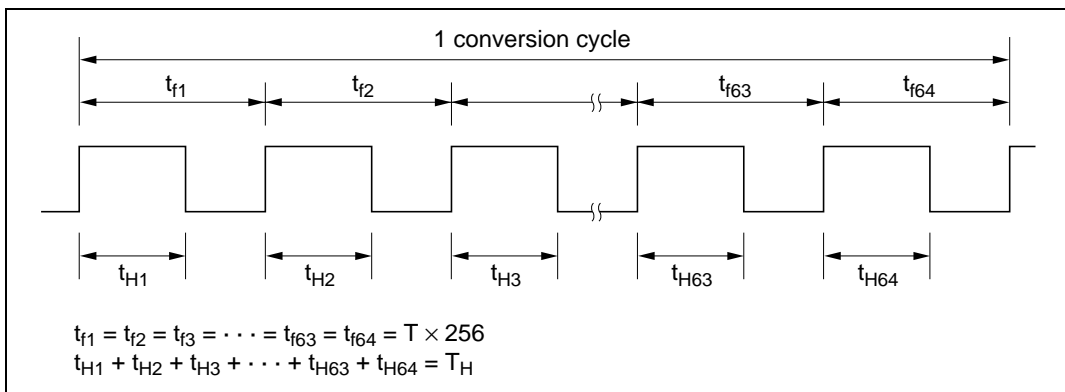


Figure 10.4 (4) Output Waveform

Section 11 16-Bit Free-Running Timer

11.1 Overview

The H8S/2138 Group and H8S/2134 Group have a single-channel on-chip 16-bit free-running timer (FRT) module that uses a 16-bit free-running counter as a time base. Applications of the FRT module include rectangular-wave output (up to two independent waveforms), input pulse width measurement, and measurement of external clock periods.

11.1.1 Features

The features of the free-running timer module are listed below.

- Selection of four clock sources
 - The free-running counter can be driven by an internal clock source ($\phi/2$, $\phi/8$, or $\phi/32$), or an external clock input (enabling use as an external event counter).
- Two independent comparators
 - Each comparator can generate an independent waveform.
- Four input capture channels
 - The current count can be captured on the rising or falling edge (selectable) of an input signal.
 - The four input capture registers can be used separately, or in a buffer mode.
- Counter can be cleared under program control
 - The free-running counters can be cleared on compare-match A.
- Seven independent interrupts
 - Two compare-match interrupts, four input capture interrupts, and one overflow interrupt can be requested independently.
- Special functions provided by automatic addition function
 - The contents of OCRAR and OCRAF can be added to the contents of OCRA automatically, enabling a periodic waveform to be generated without software intervention.
 - The contents of ICRD can be added automatically to the contents of OCRDM $\times 2$, enabling input capture operations in this interval to be restricted.

11.1.2 Block Diagram

Figure 11.1 shows a block diagram of the free-running timer.

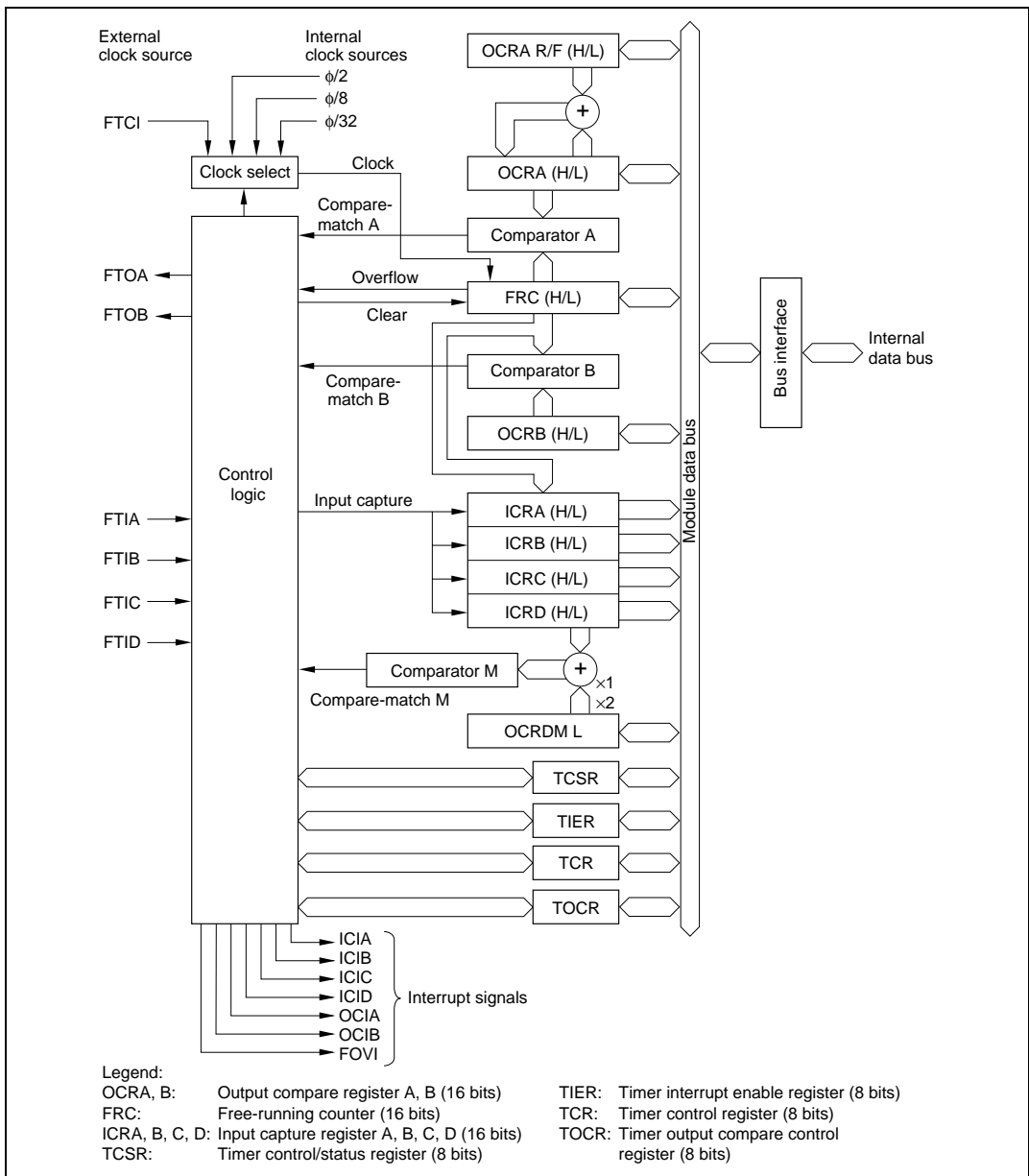


Figure 11.1 Block Diagram of 16-Bit Free-Running Timer

11.1.3 Input and Output Pins

Table 11.1 lists the input and output pins of the free-running timer module.

Table 11.1 Input and Output Pins of Free-Running Timer Module

| Name | Abbreviation | I/O | Function |
|---------------------|---------------------|------------|-------------------------|
| Counter clock input | FTCI | Input | FRC counter clock input |
| Output compare A | FTOA | Output | Output compare A output |
| Output compare B | FTOB | Output | Output compare B output |
| Input capture A | FTIA | Input | Input capture A input |
| Input capture B | FTIB | Input | Input capture B input |
| Input capture C | FTIC | Input | Input capture C input |
| Input capture D | FTID | Input | Input capture D input |

11.1.4 Register Configuration

Table 11.2 lists the registers of the free-running timer module.

Table 11.2 Register Configuration

| Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|---------------------------------------|--------------|---------------------|---------------|-----------------------|
| Timer interrupt enable register | TIER | R/W | H'01 | H'FF90 |
| Timer control/status register | TCSR | R/(W) ^{*2} | H'00 | H'FF91 |
| Free-running counter | FRC | R/W | H'0000 | H'FF92 |
| Output compare register A | OCRA | R/W | H'FFFF | H'FF94 ^{*3} |
| Output compare register B | OCRB | R/W | H'FFFF | H'FF94 ^{*3} |
| Timer control register | TCR | R/W | H'00 | H'FF96 |
| Timer output compare control register | TOCR | R/W | H'00 | H'FF97 |
| Input capture register A | ICRA | R | H'0000 | H'FF98 ^{*4} |
| Input capture register B | ICRB | R | H'0000 | H'FF9A ^{*4} |
| Input capture register C | ICRC | R | H'0000 | H'FF9C ^{*4} |
| Input capture register D | ICRD | R | H'0000 | H'FF9E |
| Output compare register AR | OCRAR | R/W | H'FFFF | H'FF98 ^{*4} |
| Output compare register AF | OCRAF | R/W | H'FFFF | H'FF9A ^{*4} |
| Output compare register DM | OCRDM | R/W | H'0000 | H'FF9C ^{*4} |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | MSTPCRL | R/W | H'FF | H'FF87 |

- Notes:
1. Lower 16 bits of the address.
 2. Bits 7 to 1 are read-only; only 0 can be written to clear the flags.
Bit 0 is readable/writable.
 3. OCRA and OCRB share the same address. Access is controlled by the OCRS bit in TOCR.
 4. ICRA, ICRB, and ICRC share the same addresses with OCRAR, OCRAF, and OCRDM. Access is controlled by the ICRS bit in TOCR.

11.2 Register Descriptions

11.2.1 Free-Running Counter (FRC)

| | | | | | | | | | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

FRC is a 16-bit readable/writable up-counter that increments on an internal pulse generated from a clock source. The clock source is selected by bits CKS1 and CKS0 in TCR.

FRC can also be cleared by compare-match A.

When FRC overflows from H'FFFF to H'0000, the overflow flag (OVF) in TCSR is set to 1.

FRC is initialized to H'0000 by a reset and in hardware standby mode.

11.2.2 Output Compare Registers A and B (OCRA, OCRB)

| | | | | | | | | | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

OCRA and OCRB are 16-bit readable/writable registers, the contents of which are continually compared with the value in the FRC. When a match is detected, the corresponding output compare flags (OCFA or OCFB) is set in TCSR.

In addition, if the output enable bit (OEA or OEB) in TOCR is set to 1, when OCR and FRC values match, the logic level selected by the output level bit (OLVLA or OLVLB) in TOCR is output at the output compare pin (FTOA or FTOB). Following a reset, the FTOA and FTOB output levels are 0 until the first compare-match.

OCR is initialized to H'FFFF by a reset and in hardware standby mode.

11.2.3 Input Capture Registers A to D (ICRA to ICRD)

| | | | | | | | | | | | | | | | | |
|---------------|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R |

There are four input capture registers, A to D, each of which is a 16-bit read-only register.

When the rising or falling edge of the signal at an input capture input pin (FTIA to FTID) is detected, the current FRC value is copied to the corresponding input capture register (ICRA to ICRD). At the same time, the corresponding input capture flag (ICFA to ICFD) in TCSR is set to 1. The input capture edge is selected by the input edge select bits (IEDGA to IEDGD) in TCR.

ICRC and ICRD can be used as ICRA and ICRB buffer registers, respectively, and made to perform buffer operations, by means of buffer enable bits A and B (BUFEA, BUFEB) in TCR.

Figure 11.2 shows the connections when ICRC is specified as the ICRA buffer register (BUFEA = 1). When ICRC is used as the ICRA buffer, both rising and falling edges can be specified as transitions of the external input signal by setting $IEDGA \neq IEDGC$. When $IEDGA = IEDGC$, either the rising or falling edge is designated. See table 11.3.

Note: The FRC contents are transferred to the input capture register regardless of the value of the input capture flag (ICF).

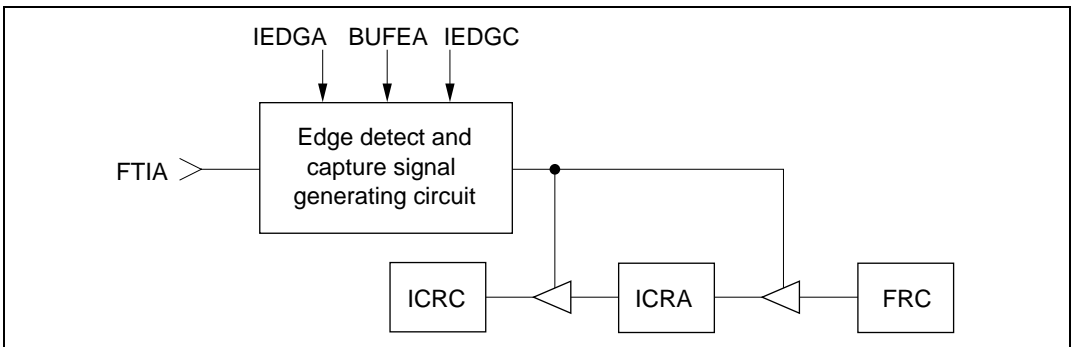


Figure 11.2 Input Capture Buffering (Example)

Table 11.3 Buffered Input Capture Edge Selection (Example)

| IEDGA | IEDGC | Description |
|-------|-------|---|
| 0 | 0 | Captured on falling edge of input capture A (FTIA) (Initial value) |
| | 1 | Captured on both rising and falling edges of input capture A (FTIA) |
| 1 | 0 | |
| | 1 | Captured on rising edge of input capture A (FTIA) |

To ensure input capture, the width of the input capture pulse should be at least 1.5 system clock periods (1.5ϕ). When triggering is enabled on both edges, the input capture pulse width should be at least 2.5 system clock periods (2.5ϕ).

ICR is initialized to H'0000 by a reset and in hardware standby mode.

11.2.4 Output Compare Registers AR and AF (OCRAR, OCRAF)

| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

OCRAR and OCRAF are 16-bit readable/writable registers.

When the OCRAMS bit in TOCR is set to 1, the operation of OCRA is changed to include the use of OCRAR and OCRAF. The contents of OCRAR and OCRAF are automatically added alternately to OCRA, and the result is written to OCRA. The write operation is performed on the occurrence of compare-match A. In the first compare-match A after the OCRAMS bit is set to 1, OCRAF is added.

The operation due to compare-match A varies according to whether the compare-match follows addition of OCRAR or OCRAF. The value of the OLVLA bit in TOCR is ignored, and 1 is output on a compare-match A following addition of OCRAF, while 0 is output on a compare-match A following addition of OCRAR.

When the OCRA automatically addition function is used, do not set internal clock $\phi/2$ as the FRC counter input clock together with an OCRAR (or OCRAF) value of H'0001 or less.

OCRAR and OCRAF are initialized to H'FFFF by a reset and in hardware standby mode.

11.2.5 Output Compare Register DM (OCRDM)

| | | | | | | | | | | | | | | | | |
|---------------|----|----|----|----|----|----|---|---|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

OCRDM is a 16-bit readable/writable register in which the upper 8 bits are fixed at H'00.

When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, the operation of ICRD is changed to include the use of OCRDM. The point at which input capture D occurs is taken as the start of a mask interval. Next, twice the contents of OCRDM is added to the contents of ICRD, and the result is compared with the FRC value. The point at which the values match is taken as the end of the mask interval. New input capture D events are disabled during the mask interval.

A mask interval is not generated when the ICRDMS bit is set to 1 and the contents of OCRDM are H'0000.

OCRDM is initialized to H'0000 by a reset and in hardware standby mode.

11.2.6 Timer Interrupt Enable Register (TIER)

| | | | | | | | | |
|---------------|-------|-------|-------|-------|-------|-------|------|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICIAE | ICIBE | ICICE | ICIDE | OCIAE | OCIBE | OVIE | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | — |

TIER is an 8-bit readable/writable register that enables and disables interrupts.

TIER is initialized to H'01 by a reset and in hardware standby mode.

Bit 7—Input Capture Interrupt A Enable (ICIAE): Selects whether to request input capture interrupt A (ICIA) when input capture flag A (ICFA) in TCSR is set to 1.

Bit 7

| ICIAE | Description |
|-------|--|
| 0 | Input capture interrupt request A (ICIA) is disabled (Initial value) |
| 1 | Input capture interrupt request A (ICIA) is enabled |

Bit 6—Input Capture Interrupt B Enable (ICIBE): Selects whether to request input capture interrupt B (ICIB) when input capture flag B (ICFB) in TCSR is set to 1.

Bit 6

| ICIBE | Description |
|-------|--|
| 0 | Input capture interrupt request B (ICIB) is disabled (Initial value) |
| 1 | Input capture interrupt request B (ICIB) is enabled |

Bit 5—Input Capture Interrupt C Enable (ICICE): Selects whether to request input capture interrupt C (ICIC) when input capture flag C (ICFC) in TCSR is set to 1.

Bit 5

| ICICE | Description |
|-------|--|
| 0 | Input capture interrupt request C (ICIC) is disabled (Initial value) |
| 1 | Input capture interrupt request C (ICIC) is enabled |

Bit 4—Input Capture Interrupt D Enable (ICIDE): Selects whether to request input capture interrupt D (ICID) when input capture flag D (ICFD) in TCSR is set to 1.

Bit 4

| ICIDE | Description |
|-------|--|
| 0 | Input capture interrupt request D (ICID) is disabled (Initial value) |
| 1 | Input capture interrupt request D (ICID) is enabled |

Bit 3—Output Compare Interrupt A Enable (OCIAE): Selects whether to request output compare interrupt A (OCIA) when output compare flag A (OCFA) in TCSR is set to 1.

Bit 3

| OCIAE | Description |
|-------|---|
| 0 | Output compare interrupt request A (OCIA) is disabled (Initial value) |
| 1 | Output compare interrupt request A (OCIA) is enabled |

Bit 2—Output Compare Interrupt B Enable (OCIBE): Selects whether to request output compare interrupt B (OCIB) when output compare flag B (OCFB) in TCSR is set to 1.

Bit 2

| OCIBE | Description |
|-------|---|
| 0 | Output compare interrupt request B (OCIB) is disabled (Initial value) |
| 1 | Output compare interrupt request B (OCIB) is enabled |

Bit 1—Timer Overflow Interrupt Enable (OVIE): Selects whether to request a free-running timer overflow interrupt (FOVI) when the timer overflow flag (OVF) in TCSR is set to 1.

Bit 1

| OVIE | Description |
|------|---|
| 0 | Timer overflow interrupt request (FOVI) is disabled (Initial value) |
| 1 | Timer overflow interrupt request (FOVI) is enabled |

Bit 0—Reserved: This bit cannot be modified and is always read as 1.

11.2.7 Timer Control/Status Register (TCSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|-------|
| | ICFA | ICFB | ICFC | ICFD | OCFA | OCFB | OVF | CCLRA |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/W |

Note: * Only 0 can be written in bits 7 to 1 to clear these flags.

TCSR is an 8-bit register used for counter clear selection and control of interrupt request signals.

TCSR is initialized to H'00 by a reset and in hardware standby mode.

Timing is described in section 11.3, Operation.

Bit 7—Input Capture Flag A (ICFA): This status flag indicates that the FRC value has been transferred to ICRA by means of an input capture signal. When BUFEA = 1, ICFA indicates that the old ICRA value has been moved into ICRC and the new FRC value has been transferred to ICRA.

ICFA must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 7

| ICFA | Description |
|------|--|
| 0 | [Clearing condition] (Initial value) Read ICFA when ICFA = 1, then write 0 in ICFA |
| 1 | [Setting condition] When an input capture signal causes the FRC value to be transferred to ICRA |

Bit 6—Input Capture Flag B (ICFB): This status flag indicates that the FRC value has been transferred to ICRB by means of an input capture signal. When BUFEA = 1, ICFB indicates that the old ICRB value has been moved into ICRD and the new FRC value has been transferred to ICRB.

ICFB must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 6

| ICFB | Description |
|------|--|
| 0 | [Clearing condition] (Initial value) Read ICFB when ICFB = 1, then write 0 in ICFB |
| 1 | [Setting condition] When an input capture signal causes the FRC value to be transferred to ICRB |

Bit 5—Input Capture Flag C (ICFC): This status flag indicates that the FRC value has been transferred to ICRC by means of an input capture signal. When BUFEA = 1, on occurrence of the signal transition in FTIC (input capture signal) specified by the IEDGC bit, ICFC is set but data is not transferred to ICRC. Therefore, in buffer operation, ICFC can be used as an external interrupt signal (by setting the ICICE bit to 1).

ICFC must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 5

| ICFC | Description |
|------|---|
| 0 | [Clearing condition] (Initial value) Read ICFC when ICFC = 1, then write 0 in ICFC |
| 1 | [Setting condition] When an input capture signal is received |

Bit 4—Input Capture Flag D (ICFD): This status flag indicates that the FRC value has been transferred to ICRD by means of an input capture signal. When BUFEB = 1, on occurrence of the signal transition in FTID (input capture signal) specified by the IEDGD bit, ICFD is set but data is not transferred to ICRD. Therefore, in buffer operation, ICFD can be used as an external interrupt by setting the ICIDE bit to 1.

ICFD must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 4

| ICFD | Description |
|------|---|
| 0 | [Clearing condition] (Initial value) Read ICFD when ICFD = 1, then write 0 in ICFD |
| 1 | [Setting condition] When an input capture signal is received |

Bit 3—Output Compare Flag A (OCFA): This status flag indicates that the FRC value matches the OCRA value. This flag must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 3

| OCFA | Description |
|------|---|
| 0 | [Clearing condition] (Initial value) Read OCFA when OCFA = 1, then write 0 in OCFA |
| 1 | [Setting condition] When FRC = OCRA |

Bit 2—Output Compare Flag B (OCFB): This status flag indicates that the FRC value matches the OCRB value. This flag must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 2

| OCFB | Description | |
|-------------|---|-----------------|
| 0 | [Clearing condition] Read OCFB when OCFB = 1, then write 0 in OCFB | (Initial value) |
| 1 | [Setting condition] When FRC = OCRB | |

Bit 1—Timer Overflow Flag (OVF): This status flag indicates that the FRC has overflowed (changed from H'FFFF to H'0000). This flag must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 1

| OVF | Description | |
|------------|--|-----------------|
| 0 | [Clearing condition] Read OVF when OVF = 1, then write 0 in OVF | (Initial value) |
| 1 | [Setting condition] When FRC changes from H'FFFF to H'0000 | |

Bit 0—Counter Clear A (CCLRA): This bit selects whether the FRC is to be cleared at compare-match A (when the FRC and OCRA values match).

Bit 0

| CCLRA | Description | |
|--------------|-----------------------------------|-----------------|
| 0 | FRC clearing is disabled | (Initial value) |
| 1 | FRC is cleared at compare-match A | |

11.2.8 Timer Control Register (TCR)

| | | | | | | | | |
|---------------|-------|-------|-------|-------|-------|-------|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IEDGA | IEDGB | IEDGC | IEDGD | BUFEA | BUFEB | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCR is an 8-bit readable/writable register that selects the rising or falling edge of the input capture signals, enables the input capture buffer mode, and selects the FRC clock source.

TCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Input Edge Select A (IEDGA): Selects the rising or falling edge of the input capture A signal (FTIA).

Bit 7

| IEDGA | Description |
|-------|---|
| 0 | Capture on the falling edge of FTIA (Initial value) |
| 1 | Capture on the rising edge of FTIA |

Bit 6—Input Edge Select B (IEDGB): Selects the rising or falling edge of the input capture B signal (FTIB).

Bit 6

| IEDGB | Description |
|-------|---|
| 0 | Capture on the falling edge of FTIB (Initial value) |
| 1 | Capture on the rising edge of FTIB |

Bit 5—Input Edge Select C (IEDGC): Selects the rising or falling edge of the input capture C signal (FTIC).

Bit 5

| IEDGC | Description |
|-------|---|
| 0 | Capture on the falling edge of FTIC (Initial value) |
| 1 | Capture on the rising edge of FTIC |

Bit 4—Input Edge Select D (IEDGD): Selects the rising or falling edge of the input capture D signal (FTID).

Bit 4

| IEDGD | Description |
|-------|---|
| 0 | Capture on the falling edge of FTID (Initial value) |
| 1 | Capture on the rising edge of FTID |

Bit 3—Buffer Enable A (BUFEA): Selects whether ICRC is to be used as a buffer register for ICRA.

Bit 3

| BUFEA | Description |
|-------|---|
| 0 | ICRC is not used as a buffer register for input capture A (Initial value) |
| 1 | ICRC is used as a buffer register for input capture A |

Bit 2—Buffer Enable B (BUFEB): Selects whether ICRD is to be used as a buffer register for ICRB.

Bit 2

| BUFEB | Description |
|-------|---|
| 0 | ICRD is not used as a buffer register for input capture B (Initial value) |
| 1 | ICRD is used as a buffer register for input capture B |

Bits 1 and 0—Clock Select (CKS1, CKS0): Select external clock input or one of three internal clock sources for the FRC. External clock pulses are counted on the rising edge of signals input to the external clock input pin (FTCI).

| Bit 1 | Bit 0 | Description |
|-------|-------|--|
| 0 | 0 | $\phi/2$ internal clock source (Initial value) |
| | 1 | $\phi/8$ internal clock source |
| 1 | 0 | $\phi/32$ internal clock source |
| | 1 | External clock source (rising edge) |

11.2.9 Timer Output Compare Control Register (TOCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|------|------|-----|-----|-------|-------|
| | ICRDMS | OCRAMS | ICRS | OCRS | OEA | OEB | OLVLA | OLVLB |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TOCR is an 8-bit readable/writable register that enables output from the output compare pins, selects the output levels, switches access between output compare registers A and B, controls the ICRD and OCRA operating mode, and switches access to input capture registers A, B, and C.

TOCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Input Capture D Mode Select (ICRDMS): Specifies whether ICRD is used in the normal operating mode or in the operating mode using OCRDM.

Bit 7

| ICRDMS | Description |
|--------|---|
| 0 | The normal operating mode is specified for ICRD (Initial value) |
| 1 | The operating mode using OCRDM is specified for ICRD |

Bit 6—Output Compare A Mode Select (OCRAMS): Specifies whether OCRA is used in the normal operating mode or in the operating mode using OCRAR and OCRAF.

Bit 6

| OCRAMS | Description |
|--------|---|
| 0 | The normal operating mode is specified for OCRA (Initial value) |
| 1 | The operating mode using OCRAR and OCRAF is specified for OCRA |

Bit 5—Input Capture Register Select (ICRS): The same addresses are shared by ICRA and OCRAR, by ICRB and OCRAF, and by ICRC and OCRDM. The ICRS bit determines which registers are selected when the shared addresses are read or written to. The operation of ICRA, ICRB, and ICRC is not affected.

Bit 5

| ICRS | Description |
|------|---|
| 0 | The ICRA, ICRB, and ICRC registers are selected (Initial value) |
| 1 | The OCRAR, OCRAF, and OCRDM registers are selected |

Bit 4—Output Compare Register Select (OCRS): OCRA and OCRB share the same address. When this address is accessed, the OCRS bit selects which register is accessed. This bit does not affect the operation of OCRA or OCRB.

Bit 4

| OCRS | Description |
|------|---|
| 0 | The OCRA register is selected (Initial value) |
| 1 | The OCRB register is selected |

Bit 3—Output Enable A (OEA): Enables or disables output of the output compare A signal (FTOA).

Bit 3

| OEA | Description |
|-----|---|
| 0 | Output compare A output is disabled (Initial value) |
| 1 | Output compare A output is enabled |

Bit 2—Output Enable B (OEB): Enables or disables output of the output compare B signal (FTOB).

Bit 2

| OEB | Description |
|-----|---|
| 0 | Output compare B output is disabled (Initial value) |
| 1 | Output compare B output is enabled |

Bit 1—Output Level A (OLVLA): Selects the logic level to be output at the FTOA pin in response to compare-match A (signal indicating a match between the FRC and OCRA values). When the OCRAMS bit is 1, this bit is ignored.

Bit 1

| OLVLA | Description |
|-------|---|
| 0 | 0 output at compare-match A (Initial value) |
| 1 | 1 output at compare-match A |

Bit 0—Output Level B (OLVLB): Selects the logic level to be output at the FTOB pin in response to compare-match B (signal indicating a match between the FRC and OCRB values).

Bit 0

| OLVLB | Description |
|-------|---|
| 0 | 0 output at compare-match B (Initial value) |
| 1 | 1 output at compare-match B |

11.2.10 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control.

When the MSTP13 bit is set to 1, FRT operation is stopped at the end of the bus cycle, and module stop mode is entered. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 5—Module Stop (MSTP13): Specifies the FRT module stop mode.

MSTPCRH**Bit 5**

| MSTP13 | Description |
|--------|---|
| 0 | FRT module stop mode is cleared |
| 1 | FRT module stop mode is set (Initial value) |

11.3 Operation

11.3.1 FRC Increment Timing

FRC increments on a pulse generated once for each period of the selected (internal or external) clock source.

Internal Clock: Any of three internal clocks ($\phi/2$, $\phi/8$, or $\phi/32$) created by division of the system clock (ϕ) can be selected by making the appropriate setting in bits CKS1 and CKS0 in TCR.

Figure 11.3 shows the increment timing.

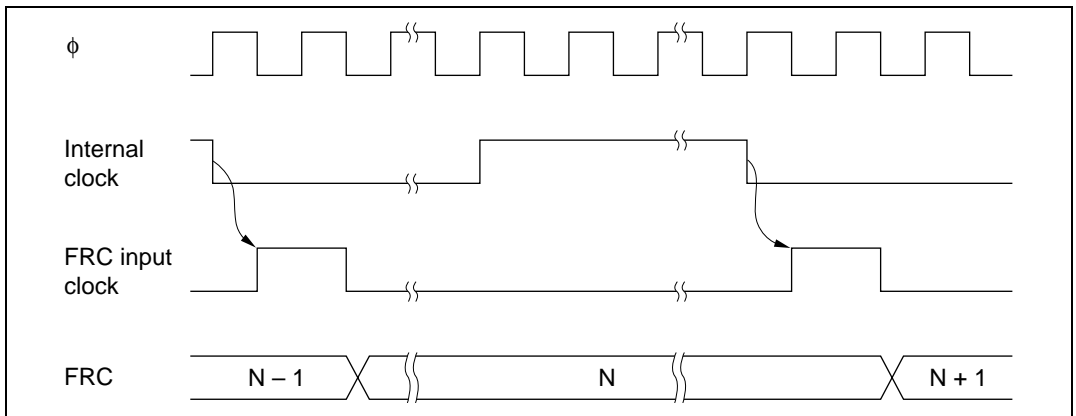


Figure 11.3 Increment Timing with Internal Clock Source

External Clock: If external clock input is selected by bits CKS1 and CKS0 in TCR, FRC increments on the rising edge of the external clock signal.

The pulse width of the external clock signal must be at least 1.5 system clock (ϕ) periods. The counter will not increment correctly if the pulse width is shorter than 1.5 system clock periods.

Figure 11.4 shows the increment timing.

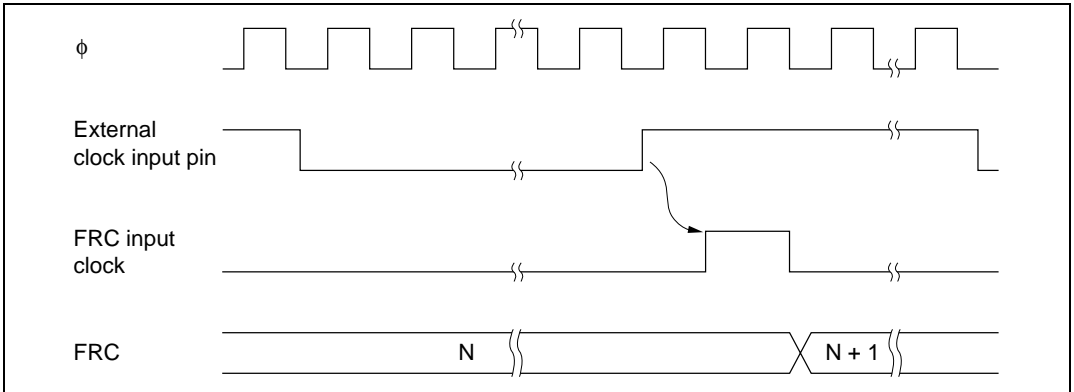
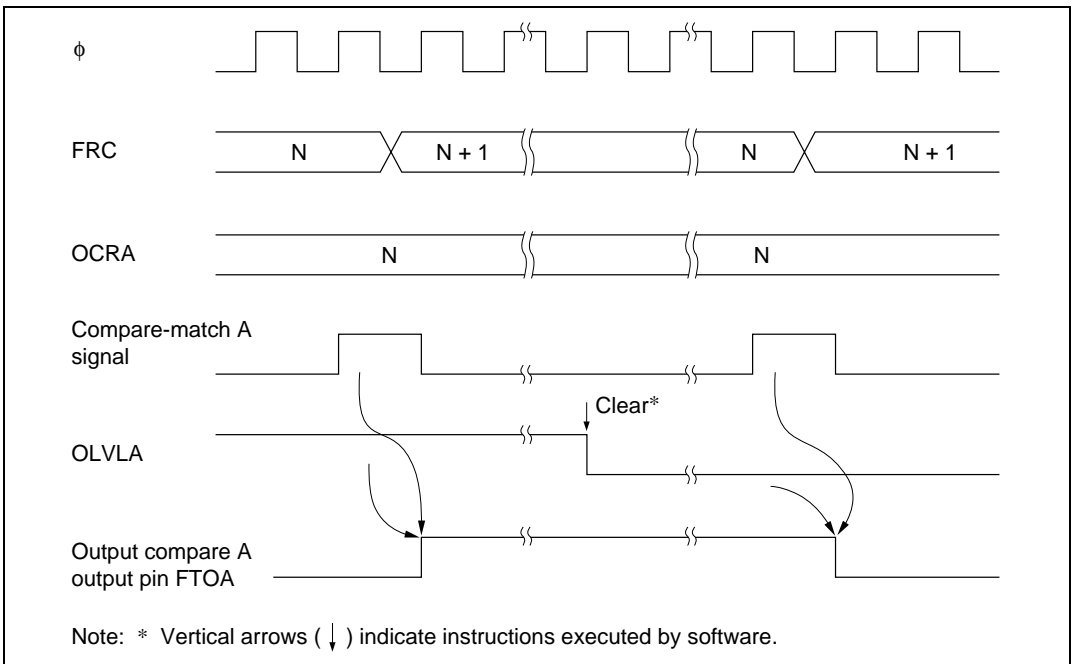


Figure 11.4 Increment Timing with External Clock Source

11.3.2 Output Compare Output Timing

When a compare-match occurs, the logic level selected by the output level bit (OLVLA or OLVLB) in TOCR is output at the output compare pin (FTOA or FTOB). Figure 11.5 shows the timing of this operation for compare-match A.



Note: * Vertical arrows (\downarrow) indicate instructions executed by software.

Figure 11.5 Timing of Output Compare A Output

11.3.3 FRC Clear Timing

FRC can be cleared when compare-match A occurs. Figure 11.6 shows the timing of this operation.

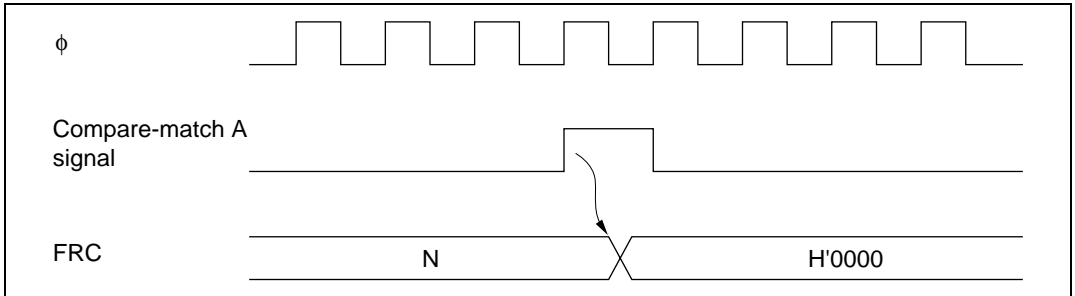


Figure 11.6 Clearing of FRC by Compare-Match A

11.3.4 Input Capture Input Timing

Input Capture Input Timing: An internal input capture signal is generated from the rising or falling edge of the signal at the input capture pin, as selected by the corresponding IEDG_x (x = A to D) bit in TCR. Figure 11.7 shows the usual input capture timing when the rising edge is selected (IEDG_x = 1).

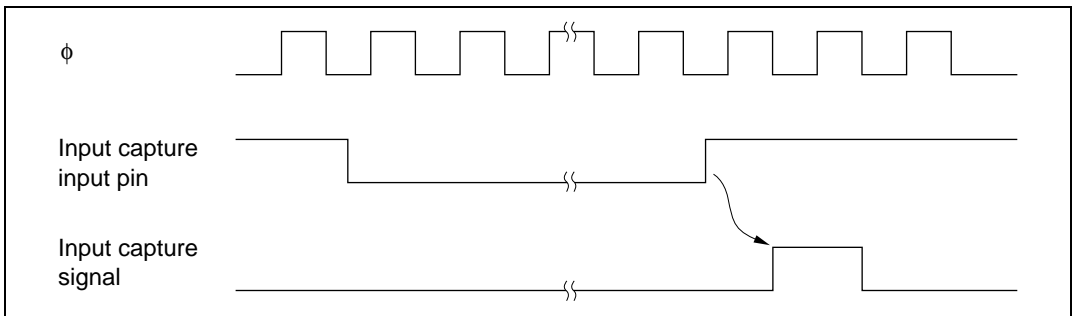


Figure 11.7 Input Capture Signal Timing (Usual Case)

If the upper byte of ICRA to ICRD is being read when the corresponding input capture signal arrives, the internal input capture signal is delayed by one system clock (ϕ) period. Figure 11.8 shows the timing for this case.

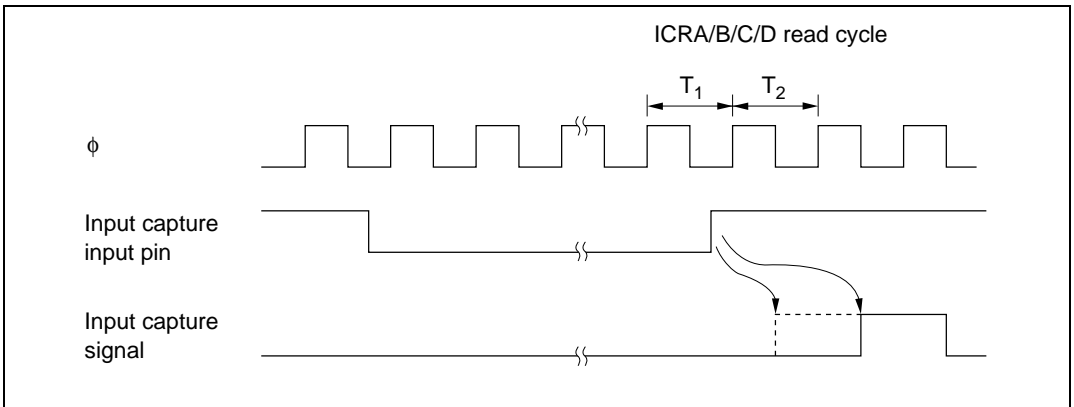


Figure 11.8 Input Capture Signal Timing
(Input Capture Input When ICRA/B/C/D Is Read)

Buffered Input Capture Input Timing: ICRC and ICRD can operate as buffers for ICRA and ICRB.

Figure 11.9 shows how input capture operates when ICRA and ICRC are used in buffer mode and IEDGA and IEDGC are set to different values (IEDGA = 0 and IEDGC = 1, or IEDGA = 1 and IEDGC = 0), so that input capture is performed on both the rising and falling edges of FTIA.

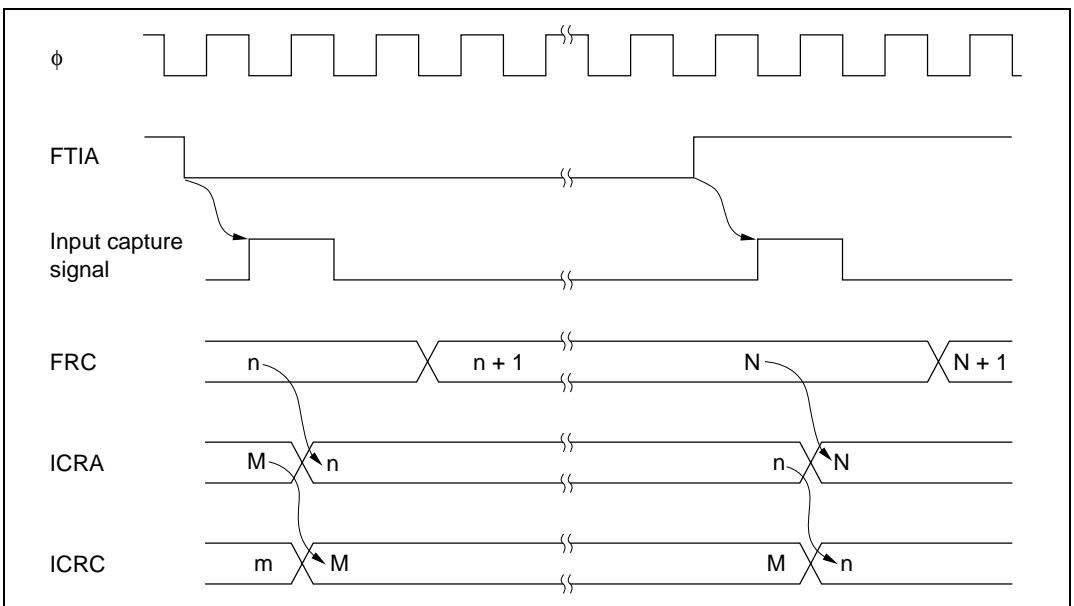


Figure 11.9 Buffered Input Capture Timing (Usual Case)

When ICRC or ICRD is used as a buffer register, its input capture flag is set by the selected transition of its input capture signal. For example, if ICRC is used to buffer ICRA, when the edge transition selected by the IEDGC bit occurs on the FTIC input capture line, ICFC will be set, and if the ICIEC bit is set, an interrupt will be requested. The FRC value will not be transferred to ICRC, however.

In buffered input capture, if the upper byte of either of the two registers to which data will be transferred (ICRA and ICRC, or ICRB and ICRD) is being read when the input signal arrives, input capture is delayed by one system clock (ϕ) period. Figure 11.10 shows the timing when BUFEA = 1.

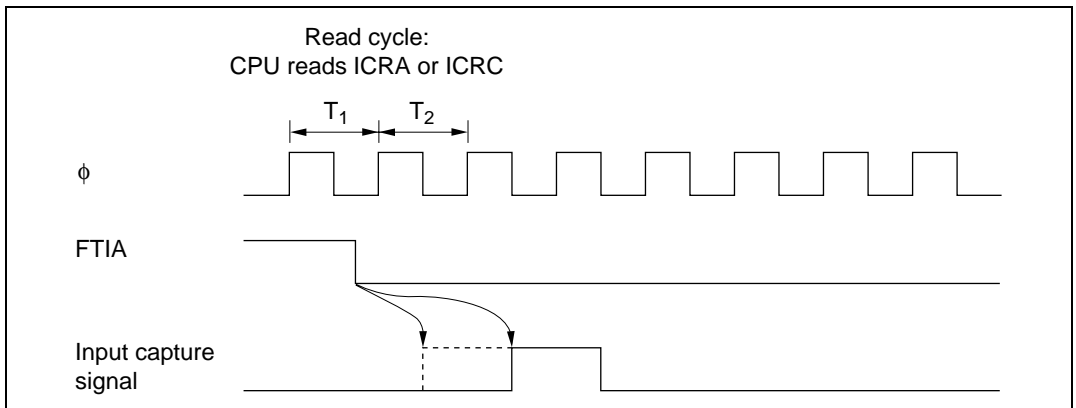


Figure 11.10 Buffered Input Capture Timing
(Input Capture Input When ICRA or ICRC Is Read)

11.3.5 Timing of Input Capture Flag (ICF) Setting

The input capture flag ICF_x ($x = A, B, C, D$) is set to 1 by the internal input capture signal. The FRC value is simultaneously transferred to the corresponding input capture register (ICR_x). Figure 11.11 shows the timing of this operation.

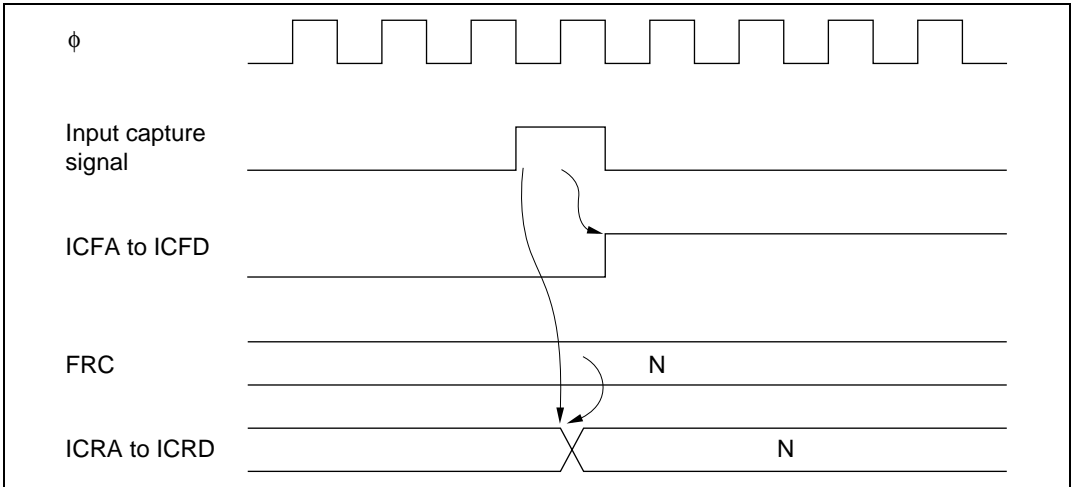


Figure 11.11 Setting of Input Capture Flag (ICFA to ICFD)

11.3.6 Setting of Output Compare Flags A and B (OCFA, OCFB)

The output compare flags are set to 1 by an internal compare-match signal generated when the FRC value matches the OCRA or OCRB value. This compare-match signal is generated at the last state in which the two values match, just before FRC increments to a new value.

Accordingly, when the FRC and OCR values match, the compare-match signal is not generated until the next period of the clock source. Figure 11.12 shows the timing of the setting of OCFA and OCFB.

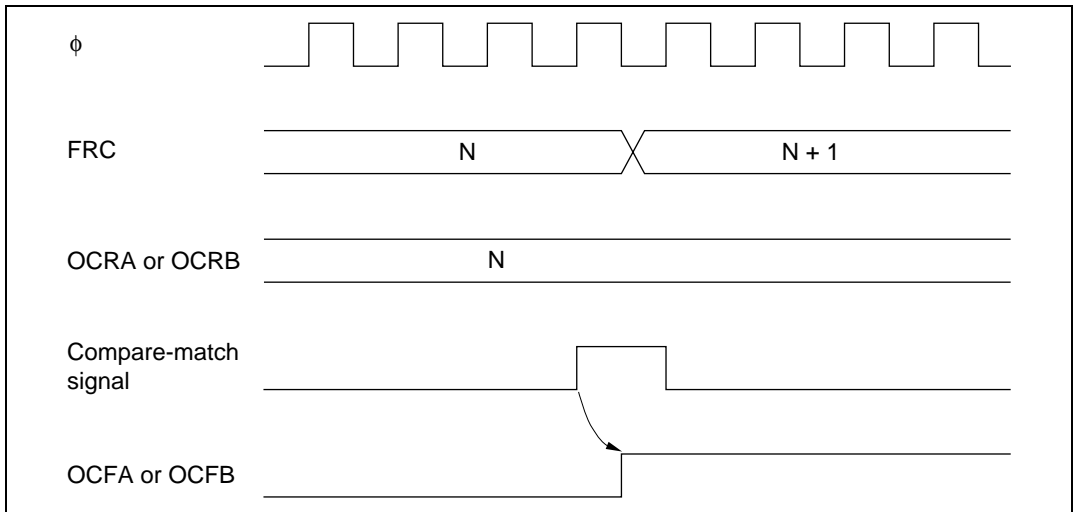


Figure 11.12 Setting of Output Compare Flag (OCFA, OCFB)

11.3.7 Setting of FRC Overflow Flag (OVF)

The FRC overflow flag (OVF) is set to 1 when FRC overflows (changes from H'FFFF to H'0000). Figure 11.13 shows the timing of this operation.

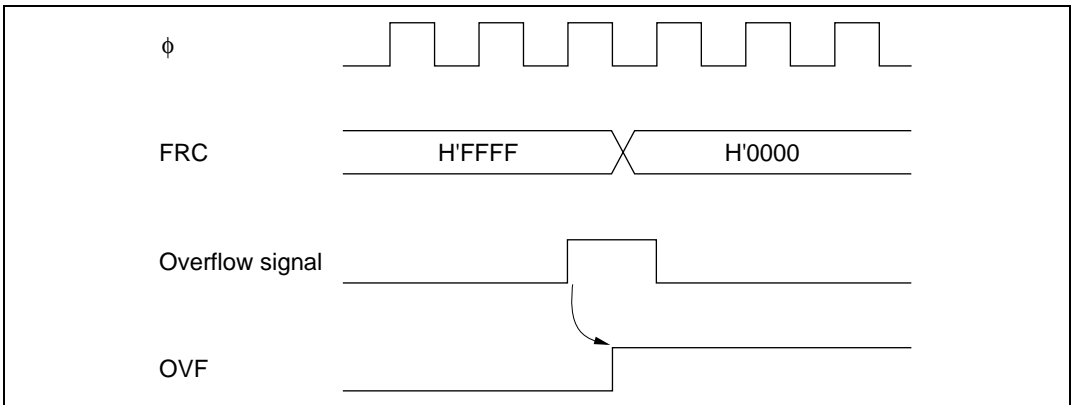


Figure 11.13 Setting of Overflow Flag (OVF)

11.3.8 Automatic Addition of OCRA and OCRAR/OCRAF

When the OCRAMS bit in TOCR is set to 1, the contents of OCRAR and OCRAF are automatically added to OCRA alternately, and when an OCRA compare-match occurs a write to OCRA is performed. The OCRA write timing is shown in figure 11.14.

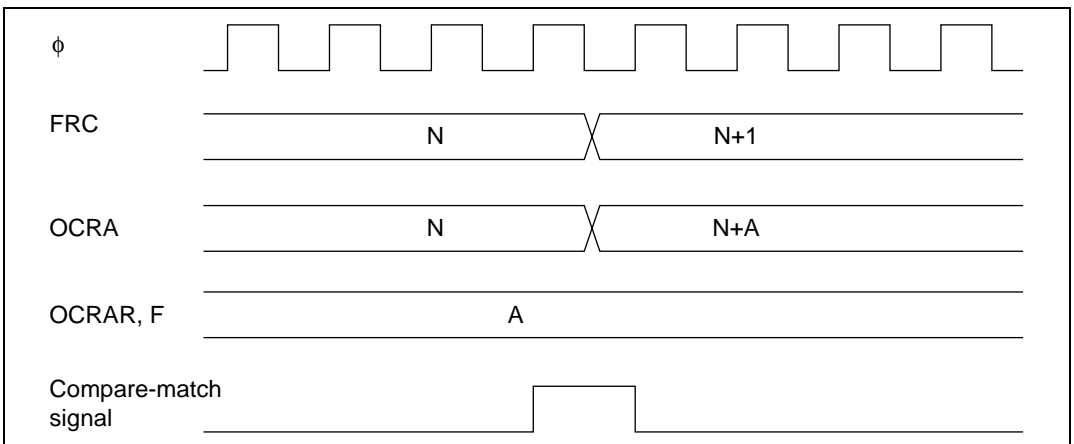


Figure 11.14 OCRA Automatic Addition Timing

11.3.9 ICRD and OCRDM Mask Signal Generation

When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, a signal that masks the ICRD input capture function is generated.

The mask signal is set by the input capture signal. The mask signal setting timing is shown in figure 11.15.

The mask signal is cleared by the sum of the ICRD contents and twice the OCRDM contents, and an FRC compare-match. The mask signal clearing timing is shown in figure 11.16.

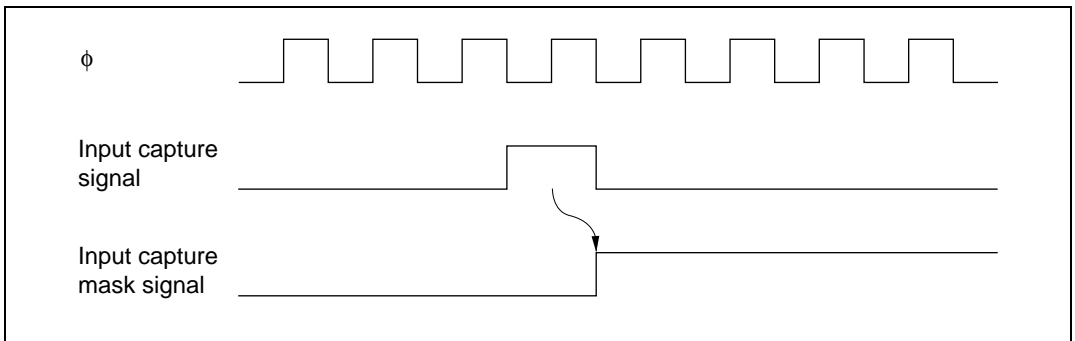


Figure 11.15 Input Capture Mask Signal Setting Timing

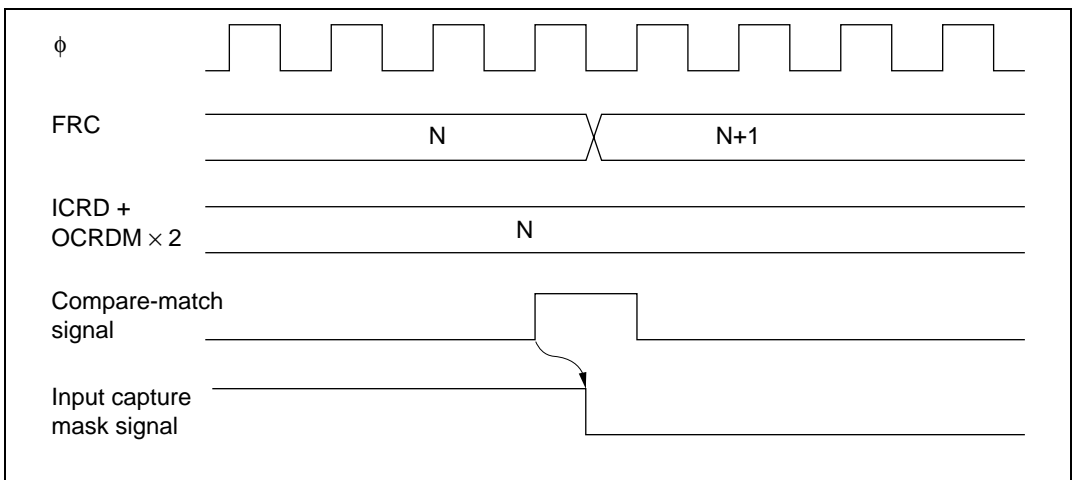



Figure 11.16 Input Capture Mask Signal Clearing Timing

11.4 Interrupts

The free-running timer can request seven interrupts (three types): input capture A to D (ICIA, ICIB, ICIC, ICID), output compare A and B (OCIA and OCIB), and overflow (FOVI). Each interrupt can be enabled or disabled by an enable bit in TIER. Independent signals are sent to the interrupt controller for each interrupt. Table 11.4 lists information about these interrupts.

Table 11.4 Free-Running Timer Interrupts

| Interrupt | Description | DTC Activation | Priority |
|-----------|-------------------|----------------|--|
| ICIA | Requested by ICFA | Possible |  |
| ICIB | Requested by ICFB | Possible | |
| ICIC | Requested by ICFC | Not possible | |
| ICID | Requested by ICFD | Not possible | |
| OCIA | Requested by OCFA | Possible | |
| OCIB | Requested by OCFB | Possible | |
| FOVI | Requested by OVF | Not possible | |

11.5 Sample Application

In the example below, the free-running timer is used to generate pulse outputs with a 50% duty cycle and arbitrary phase relationship. The programming is as follows:

- The CCLRA bit in TCSR is set to 1.
- Each time a compare-match interrupt occurs, software inverts the corresponding output level bit in TOCR (OLVLA or OLVLB).

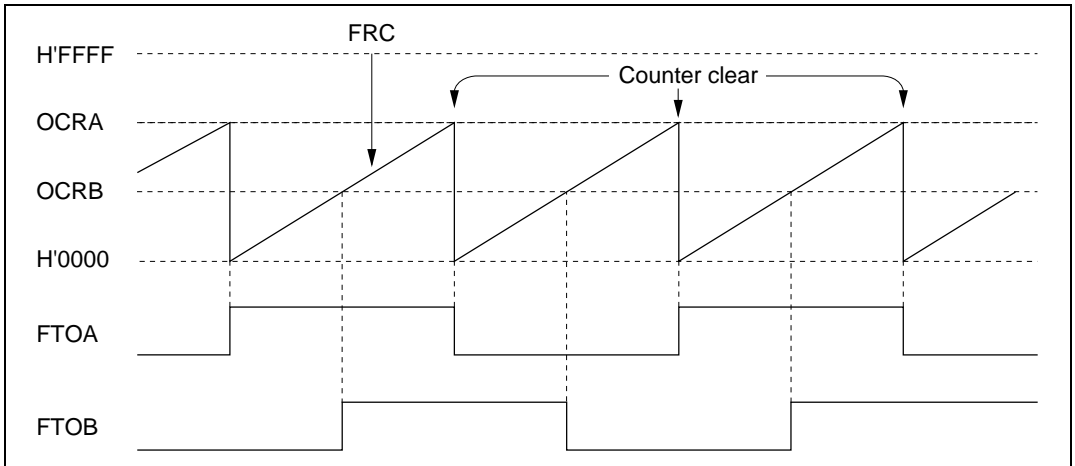


Figure 11.17 Pulse Output (Example)

11.6 Usage Notes

Application programmers should note that the following types of contention can occur in the free-running timer.

Contention between FRC Write and Clear: If an internal counter clear signal is generated during the state after an FRC write cycle, the clear signal takes priority and the write is not performed.

Figure 11.18 shows this type of contention.

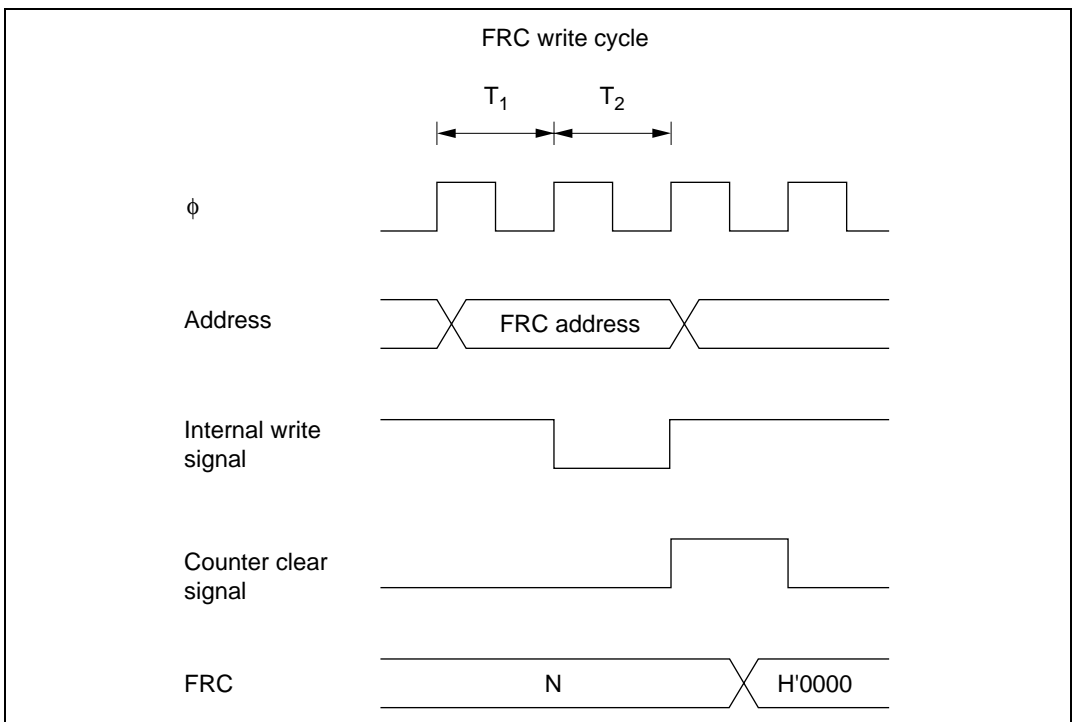


Figure 11.18 FRC Write-Clear Contention

Contention between FRC Write and Increment: If an FRC increment pulse is generated during the state after an FRC write cycle, the write takes priority and FRC is not incremented.

Figure 11.19 shows this type of contention.

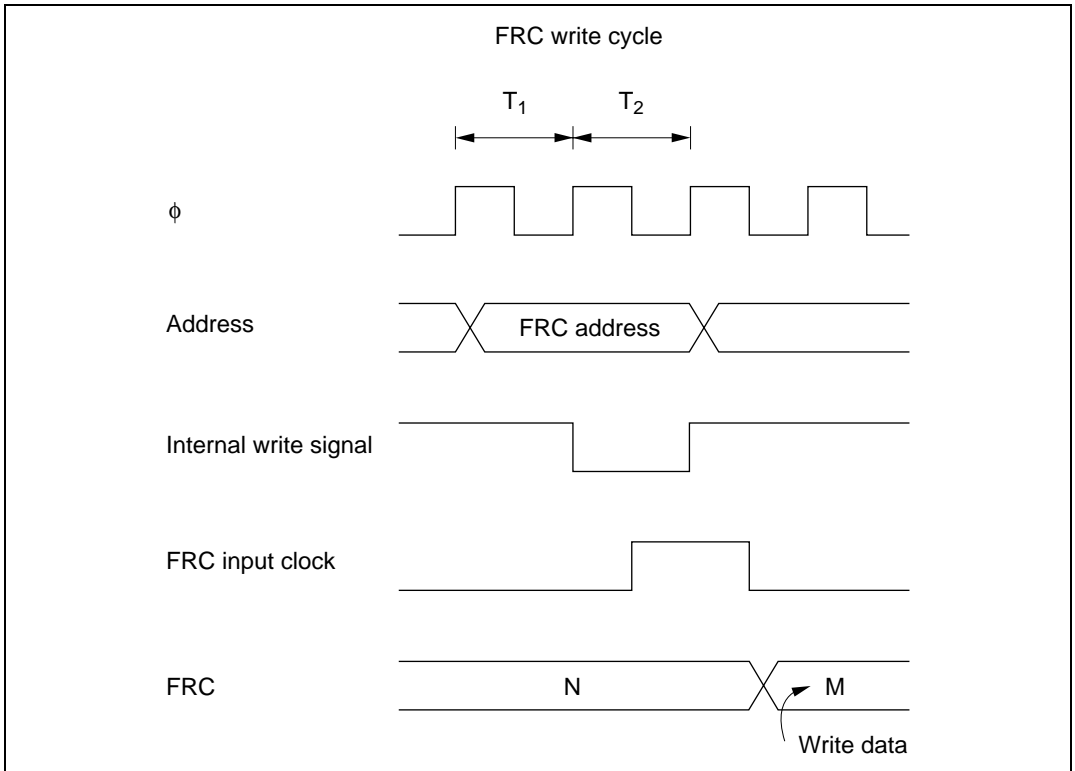


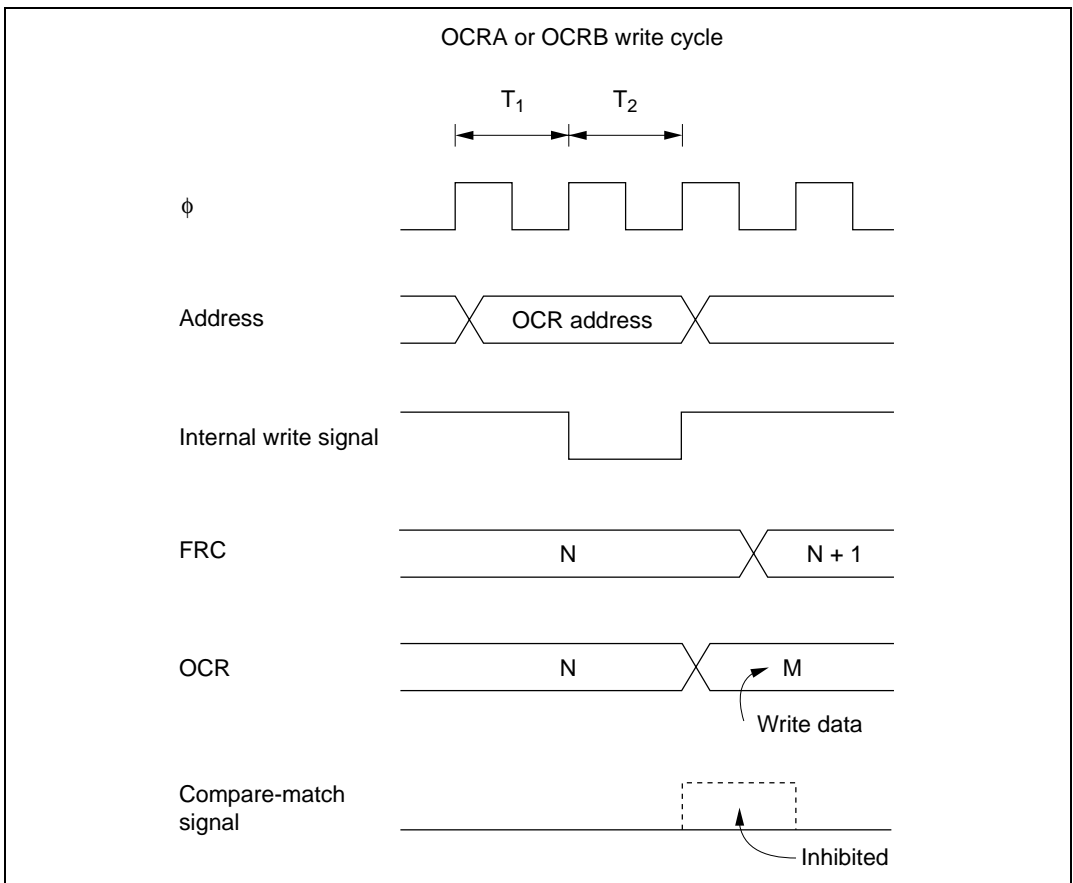
Figure 11.19 FRC Write-Increment Contention

Contention between OCR Write and Compare-Match: If a compare-match occurs during the state after an OCRA or OCRB write cycle, the write takes priority and the compare-match signal is inhibited.

Figure 11.20 shows this type of contention.

If automatic addition of OCRAR/OCRAF to OCRA is selected, and a compare-match occurs in the cycle following the OCRA, OCRAR and OCRAF write cycle, the OCRA, OCRAR and OCRAF write takes priority and the compare-match signal is inhibited. Consequently, the result of the automatic addition is not written to OCRA.

Figure 11.21 shows this type of contention.



**Figure 11.20 Contention between OCR Write and Compare-Match
(When Automatic Addition Function Is Not Used)**

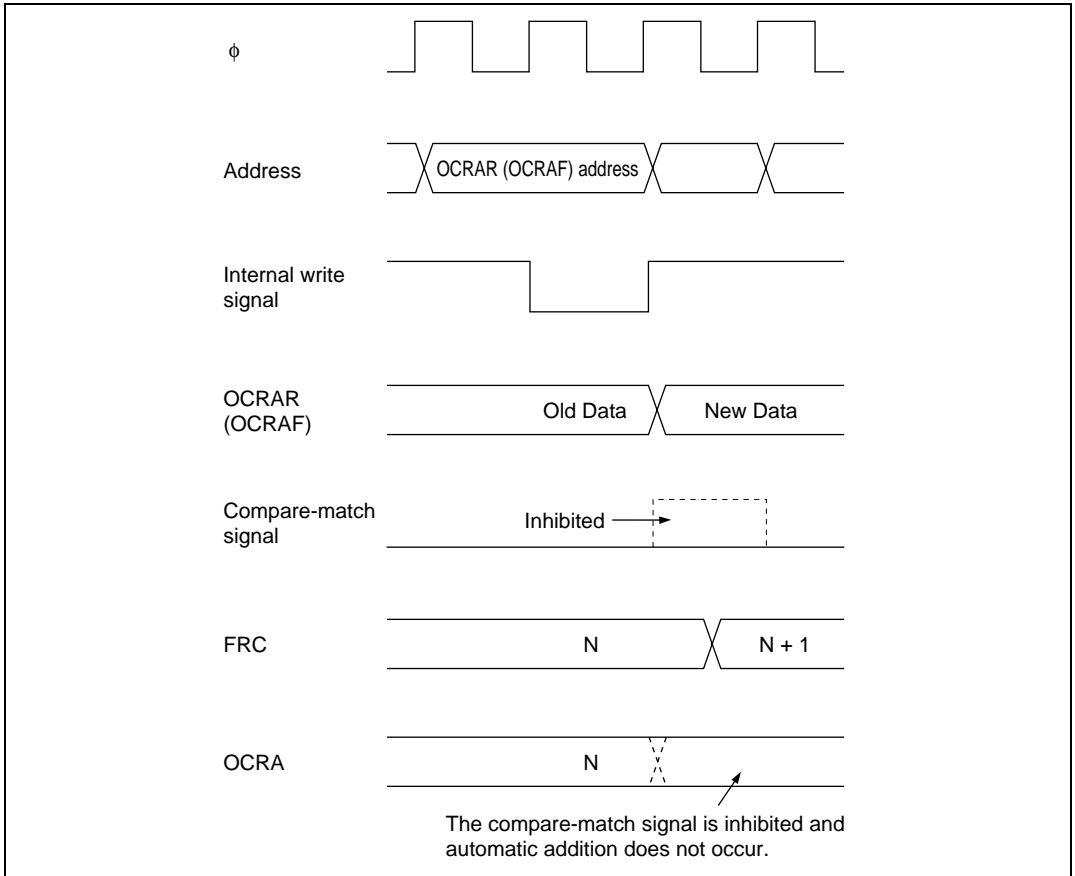


Figure 11.21 Contention between OCRAR/OCRAF Write and Compare-Match (When Automatic Addition Function Is Used)

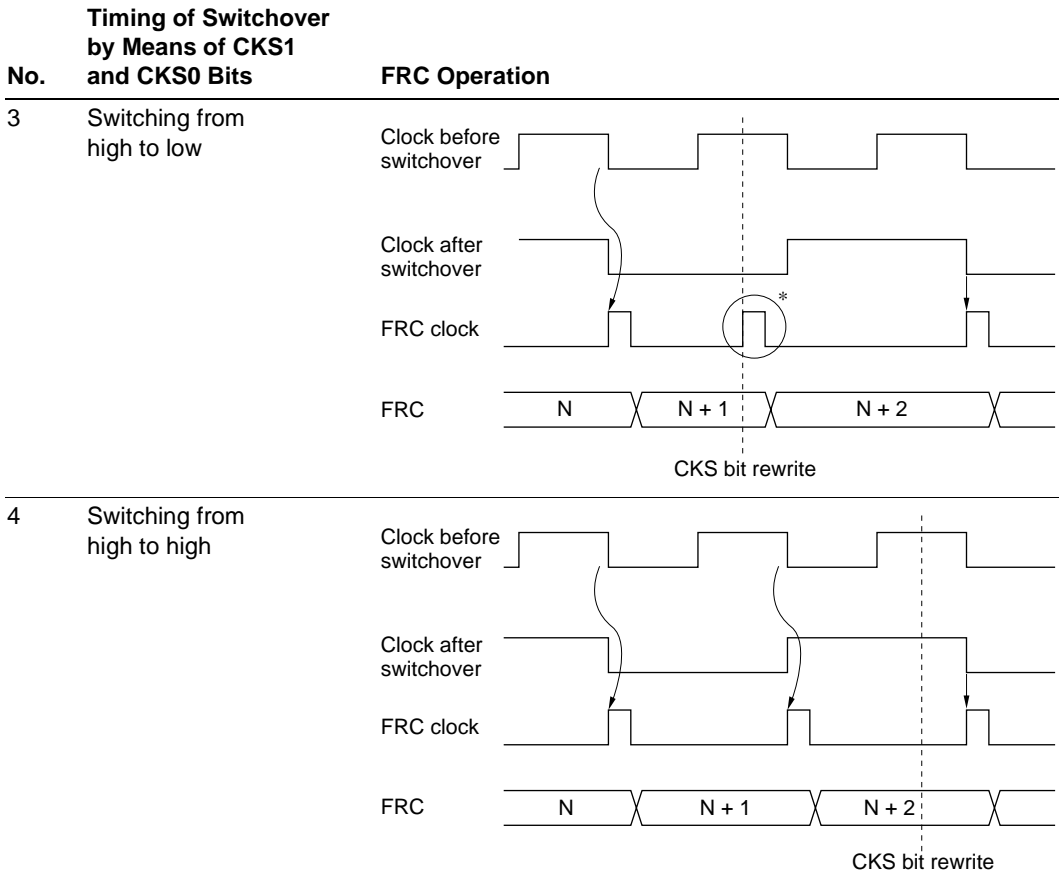
Switching of Internal Clock and FRC Operation: When the internal clock is changed, the changeover may cause FRC to increment. This depends on the time at which the clock select bits (CKS1 and CKS0) are rewritten, as shown in table 11.5.

When an internal clock is used, the FRC clock is generated on detection of the falling edge of the internal clock scaled from the system clock (ϕ). If the clock is changed when the old source is high and the new source is low, as in case no. 3 in table 11.5, the changeover is regarded as a falling edge that triggers the FRC increment clock pulse.

Switching between an internal and external clock can also cause FRC to increment.

Table 11.5 Switching of Internal Clock and FRC Operation

| No. | Timing of Switchover by Means of CKS1 and CKS0 Bits | FRC Operation |
|-----|---|---------------|
| 1 | Switching from low to low | |
| 2 | Switching from low to high | |



Note: * Generated on the assumption that the switchover is a falling edge; FRC is incremented.

Section 12 8-Bit Timers

12.1 Overview

The H8S/2138 Group and H8S/2134 Group include an 8-bit timer module with two channels (TMR0 and TMR1). Each channel has an 8-bit counter (TCNT) and two time constant registers (TCORA and TCORB) that are constantly compared with the TCNT value to detect compare-matches. The 8-bit timer module can be used as a multifunction timer in a variety of applications, such as generation of a rectangular-wave output with an arbitrary duty cycle.

The H8S/2138 Group also has two similar 8-bit timer channels (TMRX and TMRY). These channels can be used in a connected configuration using the timer connection function. TMRX and TMRY have greater input/output and interrupt function related restrictions than TMR0 and TMR1.

TMRX has a built-in H8S/2138, but does not have a built-in H8S/2134.

12.1.1 Features

- Selection of clock sources
 - TMR0, TMR1: The counter input clock can be selected from six internal clocks and an external clock (enabling use as an external event counter).
 - TMRX, TMRY: The counter input clock can be selected from three internal clocks and an external clock (enabling use as an external event counter).
- Selection of three ways to clear the counters
 - The counters can be cleared on compare-match A or B, or by an external reset signal.
- Timer output controlled by two compare-match signals
 - The timer output signal in each channel is controlled by two independent compare-match signals, enabling the timer to be used for various applications, such as the generation of pulse output or PWM output with an arbitrary duty cycle.
(Note: TMRY does not have a timer output pin.)
- Cascading of the two channels (TMR0, TMR1)
 - Operation as a 16-bit timer can be performed using channel 0 as the upper half and channel 1 as the lower half (16-bit count mode).
 - Channel 1 can be used to count channel 0 compare-match occurrences (compare-match count mode).

- Multiple interrupt sources for each channel
 - TMR0, TMR1, TMRX: Two compare-match interrupts and one overflow interrupt can be requested independently.
 - TMRX: One input capture source is available.

12.1.2 Block Diagram

Figure 12.1 shows a block diagram of the 8-bit timer module (TMR0 and TMR1).

TMRX and TMRX have a similar configuration, but cannot be cascaded. TMRX also has an input capture function. For details, see section 13, Timer Connection [H8S/2138 Group].

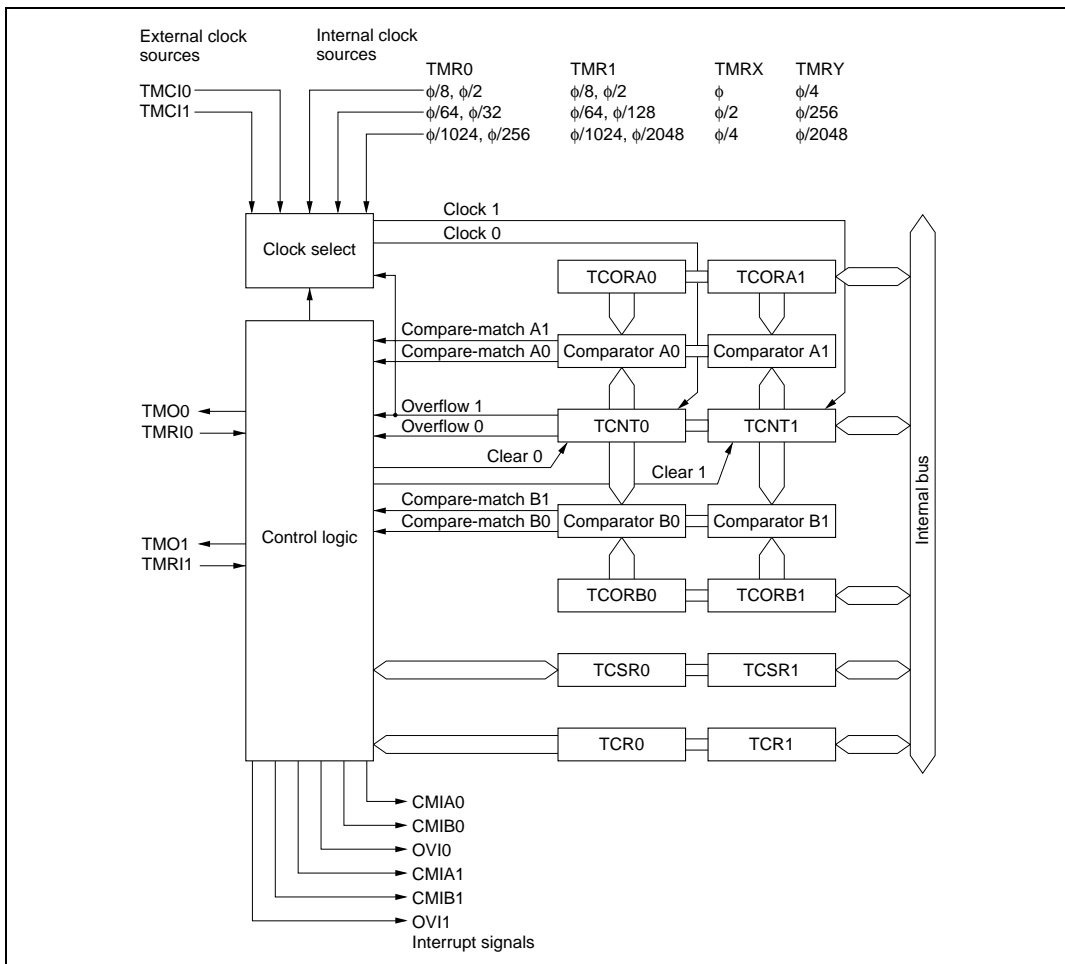


Figure 12.1 Block Diagram of 8-Bit Timer Module

12.1.3 Pin Configuration

Table 12.1 summarizes the input and output pins of the 8-bit timer module.

Table 12.1 8-Bit Timer Input and Output Pins

| Channel | Name | Symbol* | I/O | Function |
|---------|-----------------------------|-------------------------------|--------|--|
| 0 | Timer output | TMO0 | Output | Output controlled by compare-match |
| | Timer clock input | TMCI0 | Input | External clock input for the counter |
| | Timer reset input | TMRI0 | Input | External reset input for the counter |
| 1 | Timer output | TMO1 | Output | Output controlled by compare-match |
| | Timer clock input | TMCI1 | Input | External clock input for the counter |
| | Timer reset input | TMRI1 | Input | External reset input for the counter |
| X | Timer output | TMOX | Output | Output controlled by compare-match |
| | Timer clock/ reset input | HFBACKI/TMIX (TMCIX/TMRIX) | Input | External clock/reset input for the counter |
| Y | Timer clock/reset input | VSYNCI/TMIY (TMCiy/TMRIY) | Input | External clock/reset input for the counter |

Note: * The abbreviations TMO, TMCI, and TMRI are used in the text, omitting the channel number.

Channel X and Y I/O pins have the same internal configuration as channels 0 and 1, and therefore the same abbreviations are used.

12.1.4 Register Configuration

Table 12.2 summarizes the registers of the 8-bit timer module.

Table 12.2 8-Bit Timer Registers

| Channel | Name | Abbreviation ^{*3} | R/W | Initial value | Address ^{*1} |
|---------|---------------------------------|----------------------------|---------------------|---------------|-----------------------|
| 0 | Timer control register 0 | TCR0 | R/W | H'00 | H'FFC8 |
| | Timer control/status register 0 | TCSR0 | R/(W) ^{*2} | H'00 | H'FFCA |
| | Time constant register A0 | TCORA0 | R/W | H'FF | H'FFCC |
| | Time constant register B0 | TCORB0 | R/W | H'FF | H'FFCE |
| | Time counter 0 | TCNT0 | R/W | H'00 | H'FFD0 |
| 1 | Timer control register 1 | TCR1 | R/W | H'00 | H'FFC9 |
| | Timer control/status register 1 | TCSR1 | R/(W) ^{*2} | H'10 | H'FFCB |
| | Time constant register A1 | TCORA1 | R/W | H'FF | H'FFCD |
| | Time constant register B1 | TCORB1 | R/W | H'FF | H'FFCF |
| | Timer counter 1 | TCNT1 | R/W | H'00 | H'FFD1 |
| Common | Serial timer control register | STCR | R/W | H'00 | H'FFC3 |
| | Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | | MSTPCRL | R/W | H'FF | H'FF87 |
| | Timer connection register S | TCONRS | R/W | H'00 | H'FFFE |
| X | Timer control register X | TCRX | R/W | H'00 | H'FFF0 |
| | Timer control/status register X | TCSRX | R/(W) ^{*2} | H'00 | H'FFF1 |
| | Time constant register AX | TCORAX | R/W | H'FF | H'FFF6 |
| | Time constant register BX | TCORBX | R/W | H'FF | H'FFF7 |
| | Timer counter X | TCNTX | R/W | H'00 | H'FFF4 |
| | Time constant register C | TCORC | R/W | H'FF | H'FFF5 |
| | Input capture register R | TICRR | R | H'00 | H'FFF2 |
| | Input capture register F | TICRF | R | H'00 | H'FFF3 |
| Y | Timer control register Y | TCRY | R/W | H'00 | H'FFF0 |
| | Timer control/status register Y | TCSRY | R/(W) ^{*2} | H'00 | H'FFF1 |
| | Time constant register AY | TCORAY | R/W | H'FF | H'FFF2 |
| | Time constant register BY | TCORBY | R/W | H'FF | H'FFF3 |
| | Timer counter Y | TCNTY | R/W | H'00 | H'FFF4 |
| | Timer input select register | TISR | R/W | H'FE | H'FFF5 |

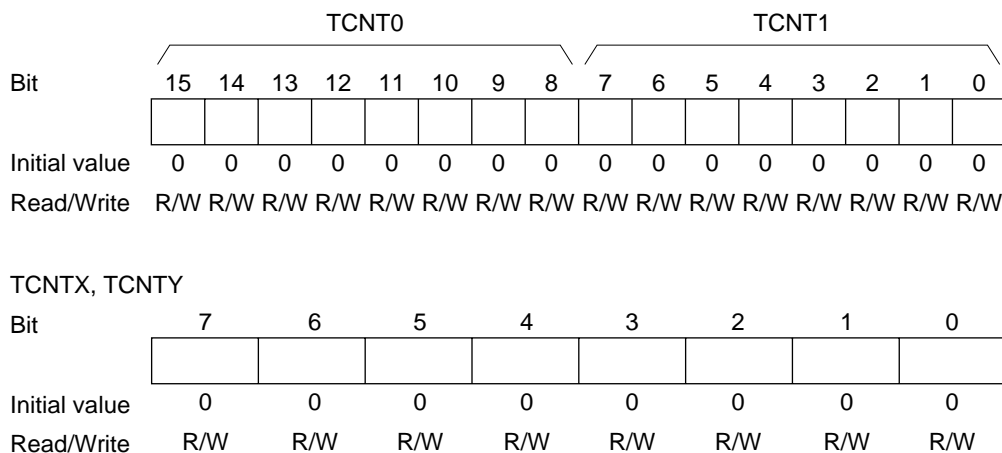
- Notes: 1. Lower 16 bits of the address.
 2. Only 0 can be written in bits 7 to 5, to clear these flags.
 3. The abbreviations TCR, TCSR, TCORA, TCORB, and TCNT are used in the text, omitting the channel designation (0, 1, X, or Y).

Each pair of registers for channel 0 and channel 1 comprises a 16-bit register with the upper 8 bits for channel 0 and the lower 8 bits for channel 1, so they can be accessed together by word access. (Access is not divided into two 8-bit accesses.)

In the H8S/2138 Group, certain of the channel X and channel Y registers are assigned to the same address. The TMRX/Y bit in TCONRS determines which register is accessed.

12.2 Register Descriptions

12.2.1 Timer Counter (TCNT)



Each TCNT is an 8-bit readable/writable up-counter.

TCNT0 and TCNT1 comprise a single 16-bit register, so they can be accessed together by word access.

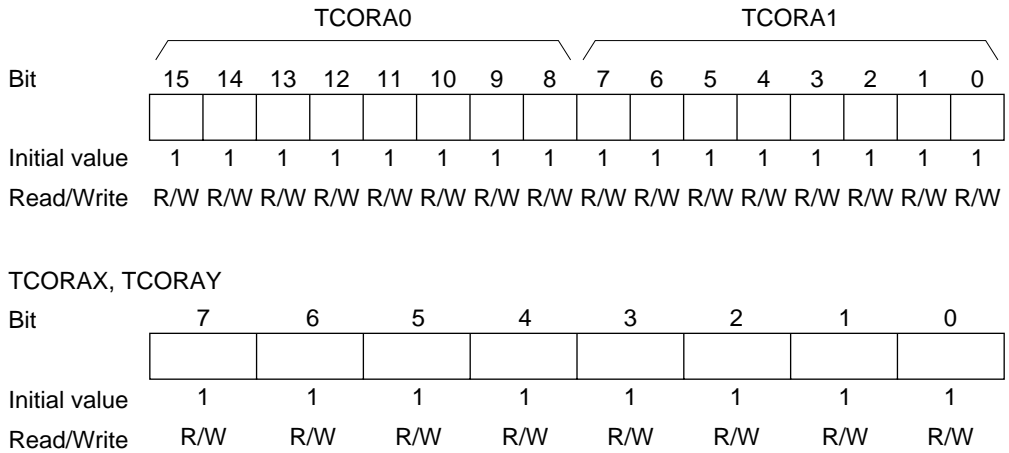
TCNT increments on pulses generated from an internal or external clock source. This clock source is selected by clock select bits CKS2 to CKS0 in TCR.

TCNT can be cleared by an external reset input signal or compare-match signal. Counter clear bits CCLR1 and CCLR0 in TCR select the method of clearing.

When TCNT overflows from H'FF to H'00, the overflow flag (OVF) in TCSR is set to 1.

The timer counters are initialized to H'00 by a reset and in hardware standby mode.

12.2.2 Time Constant Register A (TCORA)



TCORA is an 8-bit readable/writable register.

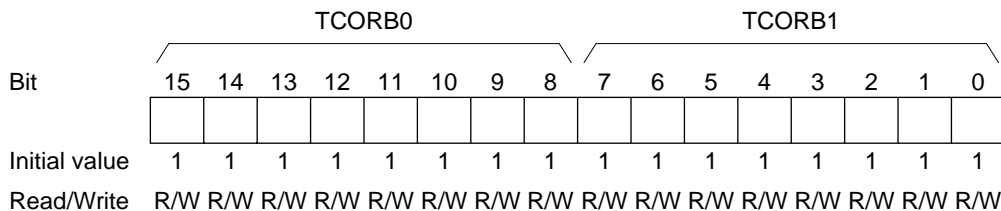
TCORA0 and TCORA1 comprise a single 16-bit register, so they can be accessed together by word access.

TCORA is continually compared with the value in TCNT. When a match is detected, the corresponding compare-match flag A (CMFA) in TCSR is set. Note, however, that comparison is disabled during the T2 state of a TCORA write cycle.

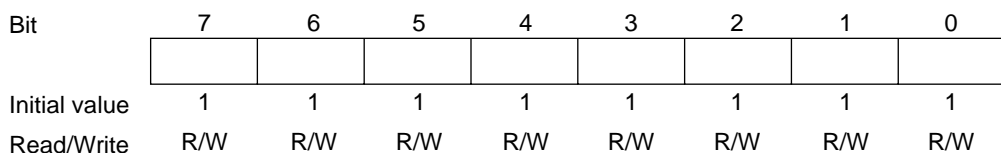
The timer output can be freely controlled by these compare-match signals and the settings of output select bits OS1 and OS0 in TCSR.

TCORA is initialized to H'FF by a reset and in hardware standby mode.

12.2.3 Time Constant Register B (TCORB)



TCORBX, TCORBY



TCORB is an 8-bit readable/writable register. TCORB0 and TCORB1 comprise a single 16-bit register, so they can be accessed together by word access.

TCORB is continually compared with the value in TCNT. When a match is detected, the corresponding compare-match flag B (CMFB) in TCSR is set. Note, however, that comparison is disabled during the T2 state of a TCORB write cycle.

The timer output can be freely controlled by these compare-match signals and the settings of output select bits OS3 and OS2 in TCSR.

TCORB is initialized to H'FF by a reset and in hardware standby mode.

12.2.4 Timer Control Register (TCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|------|-------|-------|------|------|------|
| | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCR is an 8-bit readable/writable register that selects the clock source and the time at which TCNT is cleared, and enables interrupts.

TCR is initialized to H'00 by a reset and in hardware standby mode.

For details of the timing, see section 12.3, Operation.

Bit 7—Compare-Match Interrupt Enable B (CMIEB): Selects whether the CMFB interrupt request (CMIB) is enabled or disabled when the CMFB flag in TCSR is set to 1.

Note that a CMIB interrupt is not requested by TMRX, regardless of the CMIEB value.

Bit 7

| CMIEB | Description |
|-------|---|
| 0 | CMFB interrupt request (CMIB) is disabled (Initial value) |
| 1 | CMFB interrupt request (CMIB) is enabled |

Bit 6—Compare-Match Interrupt Enable A (CMIEA): Selects whether the CMFA interrupt request (CMIA) is enabled or disabled when the CMFA flag in TCSR is set to 1.

Note that a CMIA interrupt is not requested by TMRX, regardless of the CMIEA value.

Bit 6

| CMIEA | Description |
|-------|---|
| 0 | CMFA interrupt request (CMIA) is disabled (Initial value) |
| 1 | CMFA interrupt request (CMIA) is enabled |

Bit 5—Timer Overflow Interrupt Enable (OVIE): Selects whether the OVF interrupt request (OVI) is enabled or disabled when the OVF flag in TCSR is set to 1.

Note that an OVI interrupt is not requested by TMRX, regardless of the OVIE value.

Bit 5

| OVIE | Description |
|------|---|
| 0 | OVF interrupt request (OVI) is disabled (Initial value) |
| 1 | OVF interrupt request (OVI) is enabled |

Bits 4 and 3—Counter Clear 1 and 0 (CCLR1, CCLR0): These bits select the method by which the timer counter is cleared: by compare-match A or B, or by an external reset input.

| Bit 4 | Bit 3 | Description |
|-------|-------|--|
| CCLR1 | CCLR0 | |
| 0 | 0 | Clearing is disabled (Initial value) |
| | 1 | Cleared on compare-match A |
| 1 | 0 | Cleared on compare-match B |
| | 1 | Cleared on rising edge of external reset input |

Bits 2 to 0—Clock Select 2 to 0 (CKS2 to CKS0): These bits select whether the clock input to TCNT is an internal or external clock.

The input clock can be selected from either six or three clocks, all divided from the system clock (ϕ). The falling edge of the selected internal clock triggers the count.

When use of an external clock is selected, three types of count can be selected: at the rising edge, the falling edge, and both rising and falling edges.

Some functions differ between channel 0 and channel 1, because of the cascading function.

| Channel | TCR | | | STCR | | Description |
|---------|-------|-------|-------|-------|-------|---|
| | Bit 2 | Bit 1 | Bit 0 | Bit 1 | Bit 0 | |
| | CKS2 | CKS1 | CKS0 | ICKS1 | ICKS0 | |
| 0 | 0 | 0 | 0 | — | — | Clock input disabled (Initial value) |
| | 0 | 0 | 1 | — | 0 | $\phi/8$ internal clock source, counted on the falling edge |
| | 0 | 0 | 1 | — | 1 | $\phi/2$ internal clock source, counted on the falling edge |
| | 0 | 1 | 0 | — | 0 | $\phi/64$ internal clock source, counted on the falling edge |
| | 0 | 1 | 0 | — | 1 | $\phi/32$ internal clock source, counted on the falling edge |
| | 0 | 1 | 1 | — | 0 | $\phi/1024$ internal clock source, counted on the falling edge |
| | 0 | 1 | 1 | — | 1 | $\phi/256$ internal clock source, counted on the falling edge |
| | 1 | 0 | 0 | — | — | Counted on TCNT1 overflow signal* |
| 1 | 0 | 0 | 0 | — | — | Clock input disabled (Initial value) |
| | 0 | 0 | 1 | 0 | — | $\phi/8$ internal clock source, counted on the falling edge |
| | 0 | 0 | 1 | 1 | — | $\phi/2$ internal clock source, counted on the falling edge |
| | 0 | 1 | 0 | 0 | — | $\phi/64$ internal clock source, counted on the falling edge |
| | 0 | 1 | 0 | 1 | — | $\phi/128$ internal clock source, counted on the falling edge |
| | 0 | 1 | 1 | 0 | — | $\phi/1024$ internal clock source, counted on the falling edge |
| | 0 | 1 | 1 | 1 | — | $\phi/2048$ internal clock source, counted on the falling edge |
| | 1 | 0 | 0 | — | — | Counted on TCNT0 compare-match A* |
| X | 0 | 0 | 0 | — | — | Clock input disabled (Initial value) |
| | 0 | 0 | 1 | — | — | Counted on ϕ internal clock source |
| | 0 | 1 | 0 | — | — | $\phi/2$ internal clock source, counted on the falling edge |
| | 0 | 1 | 1 | — | — | $\phi/4$ internal clock source, counted on the falling edge |
| | 1 | 0 | 0 | — | — | Clock input disabled |
| Y | 0 | 0 | 0 | — | — | Clock input disabled (Initial value) |
| | 0 | 0 | 1 | — | — | $\phi/4$ internal clock source, counted on the falling edge |
| | 0 | 1 | 0 | — | — | $\phi/256$ internal clock source, counted on the falling edge |
| | 0 | 1 | 1 | — | — | $\phi/2048$ internal clock source, counted on the falling edge |
| | 1 | 0 | 0 | — | — | Clock input disabled |
| Common | 1 | 0 | 1 | — | — | External clock source, counted at rising edge |
| | 1 | 1 | 0 | — | — | External clock source, counted at falling edge |
| | 1 | 1 | 1 | — | — | External clock source, counted at both rising and falling edges |

Note: * If the count input of channel 0 is the TCNT1 overflow signal and that of channel 1 is the TCNT0 compare-match signal, no incrementing clock will be generated. Do not use this setting.

12.2.5 Timer Control/Status Register (TCSR)

TCSR0

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|------|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | ADTE | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/W | R/W | R/W | R/W | R/W |

TCSR1

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|---|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | — | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | — | R/W | R/W | R/W | R/W |

TCSRX

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | ICF | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/W | R/W | R/W | R/W |

TCSR Y

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|------|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | ICIE | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/W | R/W | R/W | R/W | R/W |

Note: * Only 0 can be written in bits 7 to 5, and in bit 4 in TCSRX, to clear these flags.

TCSR is an 8-bit register that indicates compare-match and overflow statuses (and input capture status in TMRX only), and controls compare-match output.

TCSR0, TCSRX, and TCSR Y are initialized to H'00, and TCSR1 is initialized to H'10, by a reset and in hardware standby mode.

Bit 7—Compare-Match Flag B (CMFB): Status flag indicating whether the values of TCNT and TCORB match.

Bit 7

| CMFB | Description | |
|------|--|-----------------|
| 0 | [Clearing conditions] | (Initial value) |
| | <ul style="list-style-type: none"> • Read CMFB when CMFB = 1, then write 0 in CMFB • When the DTC is activated by a CMIB interrupt | |
| 1 | [Setting condition] | |
| | When TCNT = TCORB | |

Bit 6—Compare-match Flag A (CMFA): Status flag indicating whether the values of TCNT and TCORA match.

Bit 6

| CMFA | Description | |
|------|--|-----------------|
| 0 | [Clearing conditions] | (Initial value) |
| | <ul style="list-style-type: none"> • Read CMFA when CMFA = 1, then write 0 in CMFA • When the DTC is activated by a CMIA interrupt | |
| 1 | [Setting condition] | |
| | When TCNT = TCORA | |

Bit 5—Timer Overflow Flag (OVF): Status flag indicating that TCNT has overflowed (changed from H'FF to H'00).

Bit 5

| OVF | Description | |
|-----|--|-----------------|
| 0 | [Clearing condition] | (Initial value) |
| | Read OVF when OVF = 1, then write 0 in OVF | |
| 1 | [Setting condition] | |
| | When TCNT overflows from H'FF to H'00 | |

TCSR0

Bit 4—A/D Trigger Enable (ADTE): Enables or disables A/D converter start requests by compare-match A.

Bit 4

| ADTE | Description |
|------|--|
| 0 | A/D converter start requests by compare-match A are disabled (Initial value) |
| 1 | A/D converter start requests by compare-match A are enabled |

TCSR1

Bit 4—Reserved: This bit cannot be modified and is always read as 1.

TCSRX

Bit 4—Input Capture Flag (ICF): Status flag that indicates detection of a rising edge followed by a falling edge in the external reset signal after the ICST bit in TCONRI has been set to 1.

Bit 4

| ICF | Description |
|-----|--|
| 0 | [Clearing condition] (Initial value) Read ICF when ICF = 1, then write 0 in ICF |
| 1 | [Setting condition] When a rising edge followed by a falling edge is detected in the external reset signal after the ICST bit in TCONRI has been set to 1 |

TCSRY

Bit 4—Input Capture Interrupt Enable (ICIE): Selects enabling or disabling of the interrupt request by ICF (ICIX) when the ICF bit in TCSRX is set to 1.

Bit 4

| ICIE | Description |
|------|---|
| 0 | Interrupt request by ICF (ICIX) is disabled (Initial value) |
| 1 | Interrupt request by ICF (ICIX) is enabled |

Bits 3 to 0—Output Select 3 to 0 (OS3 to OS0): These bits specify how the timer output level is to be changed by a compare-match of TCOR and TCNT.

OS3 and OS2 select the effect of compare-match B on the output level, OS1 and OS0 select the effect of compare-match A on the output level, and both of them can be controlled independently.

Note, however, that priorities are set such that: trigger output > 1 output > 0 output. If compare-matches occur simultaneously, the output changes according to the compare-match with the higher priority.

Timer output is disabled when bits OS3 to OS0 are all 0.

After a reset, the timer output is 0 until the first compare-match occurs.

| Bit 3 | Bit 2 | | |
|-------|-------|--|-----------------|
| OS3 | OS2 | Description | |
| 0 | 0 | No change when compare-match B occurs | (Initial value) |
| | 1 | 0 is output when compare-match B occurs | |
| 1 | 0 | 1 is output when compare-match B occurs | |
| | 1 | Output is inverted when compare-match B occurs (toggle output) | |

| Bit 1 | Bit 0 | | |
|-------|-------|--|-----------------|
| OS1 | OS0 | Description | |
| 0 | 0 | No change when compare-match A occurs | (Initial value) |
| | 1 | 0 is output when compare-match A occurs | |
| 1 | 0 | 1 is output when compare-match A occurs | |
| | 1 | Output is inverted when compare-match A occurs (toggle output) | |

12.2.6 Serial Timer Control Register (STCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-------|-------|------|-------|-----|-------|-------|
| | — | IICX1 | IICX0 | IICE | FLSHE | — | ICKS1 | ICKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), and on-chip flash memory (in F-ZTAT versions), and also selects the TCNT input clock.

For details on functions not related to the 8-bit timers, see section 3.2.4, Serial Timer Control Register (STCR), and the descriptions of the relevant modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Reserved: Do not write 1 to this bit.

Bits 6 to 4—I²C Control (IICX1, IICX0, IICE): These bits control the operation of the I²C bus interface when the IIC option is included on-chip. See section 16.2.7, Serial Timer Control Register (STCR), for details.

Bit 3—Flash Memory Control Register Enable (FLSHE): Controls CPU access to the flash memory control registers, the power-down mode control registers, and the supporting module control registers. See section 3.2.4, Serial Timer Control Register (STCR), for details.

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits, together with bits CKS2 to CKS0 in TCR, select the clock to be input to TCNT. For details, see section 12.2.4, Timer Control Register.

12.2.7 System Control Register (SYSCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|------|-------|-----|------|
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

Only bit 1 is described here. For details on functions not related to the 8-bit timers, see sections 3.2.2 and 5.2.1, System Control Register (SYSCR), and the descriptions of the relevant modules.

Bit 1—Host Interface Enable (HIE): Controls CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers.

Bit 1

| HIE | Description |
|-----|--|
| 0 | CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers, is enabled (Initial value) |
| 1 | CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers, is disabled |

12.2.8 Timer Connection Register S (TCONRS)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | TMRX/Y | ISGENE | HOMOD1 | HOMOD0 | VOMOD1 | VOMOD0 | CLMOD1 | CLMOD0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCONRS is an 8-bit readable/writable register that controls access to the TMRX and TMR Y registers and timer connection operation.

TCONRS is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—TMRX/TMRY Access Select (TMRX/Y): The TMRX and TMRY registers can only be accessed when the HIE bit in SYSCR is cleared to 0. In the H8S/2138 Group, some of the TMRX registers and the TMRY registers are assigned to the same memory space addresses (H'FFF0 to H'FFF5), and the TMRX/Y bit determines which registers are accessed. In the H8S/2134 Group, there is no control of TMRY register access by this bit.

| Bit 7 | Accessible Registers | | | | | | | | |
|-------|-------------------------|-----------------|-----------------|------------------|------------------|-----------------|------------------|------------------|--------|
| | TMRX/Y | H'FFF0 | H'FFF1 | H'FFF2 | H'FFF3 | H'FFF4 | H'FFF5 | H'FFF6 | H'FFF7 |
| 0 | TCRX (Initial value) | TCSRX (TMRX) | TICRR (TMRX) | TICRF (TMRX) | TCNTX (TMRX) | TCORC (TMRX) | TCORAX (TMRX) | TCORBX (TMRX) | |
| 1 | | TCRY (TMRY) | TCSRY (TMRY) | TCORAY (TMRY) | TCORBY (TMRY) | TCNTY (TMRY) | TISR (TMRY) | | |

12.2.9 Input Capture Register (TICR) [TMRX Additional Function]

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | — | — | — |

TICR is an 8-bit internal register to which the contents of TCNT are transferred on the falling edge of external reset input. The CPU cannot read or write to TICR directly.

The TICR function is used in timer connection. For details, see section 13, Timer Connection [H8S/2138 Group].

12.2.10 Time Constant Register C (TCORC) [TMRX Additional Function]

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCORC is an 8-bit readable/writable register. The sum of the contents of TCORC and TICC is continually compared with the value in TCNT. When a match is detected, a compare-match C signal is generated. Note, however, that comparison is disabled during the T2 state of a TCORC write cycle and a TICC input capture cycle.

TCORC is initialized to H'FF by a reset and in hardware standby mode.

The TCORC function is used in timer connection. For details, see section 13, Timer Connection [H8S/2138 Group].

12.2.11 Input Capture Registers R and F (TICRR, TICRF) [TMRX Additional Functions]

| | | | | | | | | |
|---------------|---|---|---|---|---|---|---|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

TICRR and TICRF are 8-bit read-only registers. When the ICST bit in TCONRI is set to 1, TICRR and TICRF capture the contents of TCNT successively on the rise and fall of the external reset input. When one capture operation ends, the ICST bit is cleared to 0.

TICRR and TICRF are each initialized to H'00 by a reset and in hardware standby mode.

The TICRR and TICRF functions are used in timer connection. For details, see section 12.3.6, Input Capture Operation, and section 13, Timer Connection [H8S/2138 Group].

12.2.12 Timer Input Select Register (TISR) [TMRY Additional Function]

| | | | | | | | | |
|---------------|---|---|---|---|---|---|---|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | — | — | — | — | — | — | — | IS |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| Read/Write | — | — | — | — | — | — | — | R/W |

TISR is an 8-bit readable/writable register that selects the external clock/reset signal source for the counter.

TISR is initialized to H'FE by a reset and in hardware standby mode.

Bits 7 to 1—Reserved: Do not write 0 to these bits.

Bit 0—Input Select (IS): Selects the internal synchronization signal (IVG signal) or the timer clock/reset input pin (VSYNCCI/TMIY (TMCIIY/TMRIY)) as the external clock/reset signal source for the counter.

Bit 0

| IS | Description | |
|----|--|-----------------|
| 0 | IVG signal is selected (H8S/2138 Group) External clock/reset input is disabled (H8S/2134 Group) | (Initial value) |
| 1 | VSYNCCI/TMIY (TMCIIY/TMRIY) is selected | |

12.2.13 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP12 bit or MSTP8 bit is set to 1, 8-bit timer operation is halted on channels 0 and 1 or channels X and Y, respectively, and a transition is made to module stop mode. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 4—Module Stop (MSTP12): Specifies 8-bit timer (channel 0/1) module stop mode.

MSTPCRH Bit 4

| MSTP12 | Description |
|--------|---|
| 0 | 8-bit timer (channel 0/1) module stop mode is cleared |
| 1 | 8-bit timer (channel 0/1) module stop mode is set (Initial value) |

MSTPCRH Bit 0—Module Stop (MSTP8): Specifies 8-bit timer (channel X/Y) and timer connection module stop mode.

MSTPCRH Bit 0

| MSTP8 | Description |
|-------|--|
| 0 | 8-bit timer (channel X/Y) and timer connection module stop mode is cleared |
| 1 | 8-bit timer (channel X/Y) and timer connection module stop mode is set (Initial value) |

12.3 Operation

12.3.1 TCNT Incrementation Timing

TCNT is incremented by input clock pulses (either internal or external).

Internal Clock: An internal clock created by dividing the system clock (ϕ) can be selected by setting bits CKS2 to CKS0 in TCR. Figure 12.2 shows the count timing.

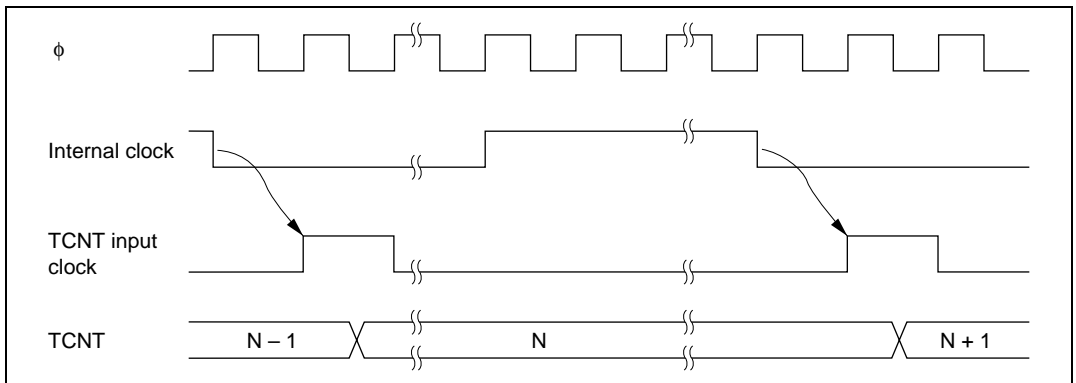


Figure 12.2 Count Timing for Internal Clock Input

External Clock: Three incrementation methods can be selected by setting bits CKS2 to CKS0 in TCR: at the rising edge, the falling edge, and both rising and falling edges.

Note that the external clock pulse width must be at least 1.5 states for incrementation at a single edge, and at least 2.5 states for incrementation at both edges. The counter will not increment correctly if the pulse width is less than these values.

Figure 12.3 shows the timing of incrementation at both edges of an external clock signal.

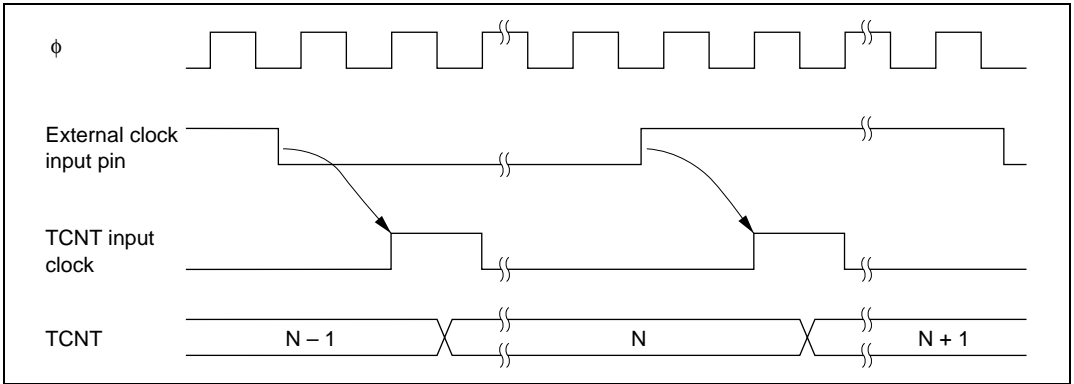


Figure 12.3 Count Timing for External Clock Input

12.3.2 Compare-Match Timing

Setting of Compare-Match Flags A and B (CMFA, CMFB): The CMFA and CMFB flags in TCSR are set to 1 by a compare-match signal generated when the TCOR and TCNT values match. The compare-match signal is generated at the last state in which the match is true, just before the timer counter is updated.

Therefore, when TCOR and TCNT match, the compare-match signal is not generated until the next incrementation clock input. Figure 12.4 shows this timing.

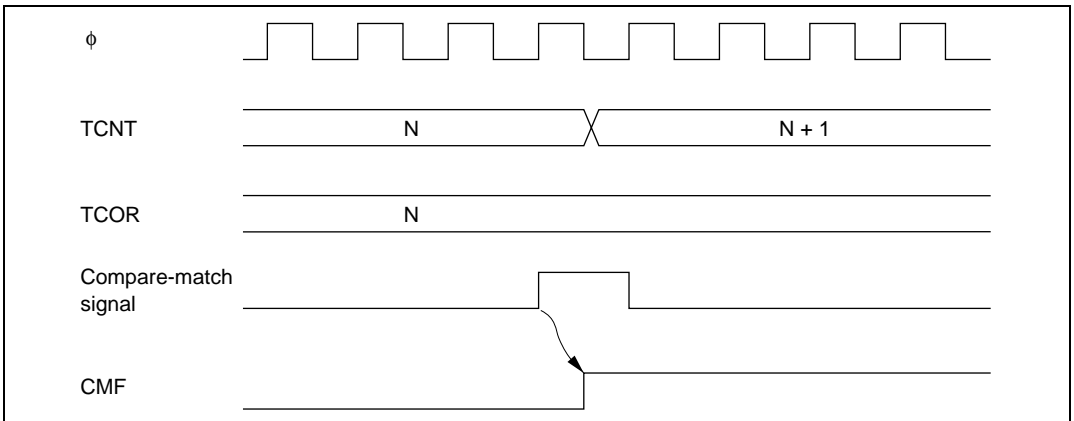


Figure 12.4 Timing of CMF Setting

Timer Output Timing: When compare-match A or B occurs, the timer output changes as specified by the output select bits (OS3 to OS0) in TCSR. Depending on these bits, the output can remain the same, be set to 0, be set to 1, or toggle.

Figure 12.5 shows the timing when the output is set to toggle at compare-match A.

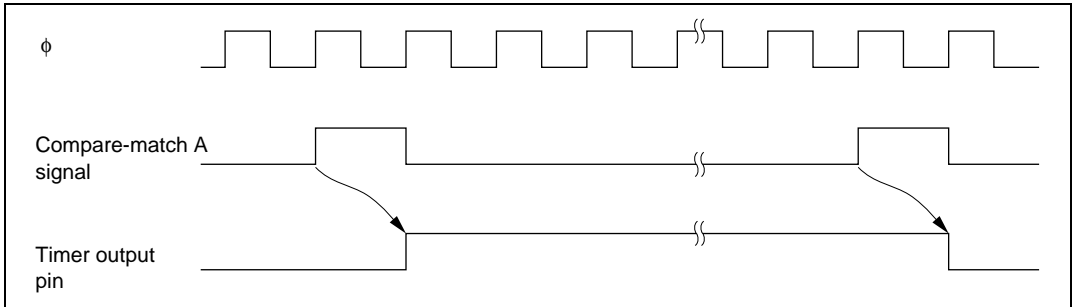


Figure 12.5 Timing of Timer Output

Timing of Compare-Match Clear: TCNT is cleared when compare-match A or B occurs, depending on the setting of the CCLR1 and CCLR0 bits in TCR. Figure 12.6 shows the timing of this operation.

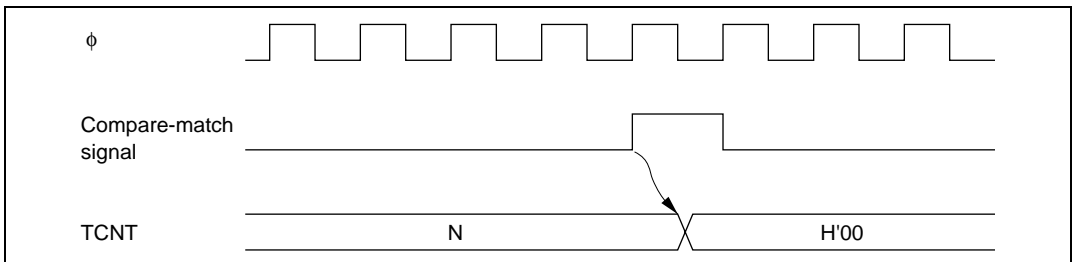


Figure 12.6 Timing of Compare-Match Clear

12.3.3 TCNT External Reset Timing

TCNT is cleared at the rising edge of an external reset input, depending on the settings of the CCLR1 and CCLR0 bits in TCR. The width of the clearing pulse must be at least 1.5 states. Figure 12.7 shows the timing of this operation.

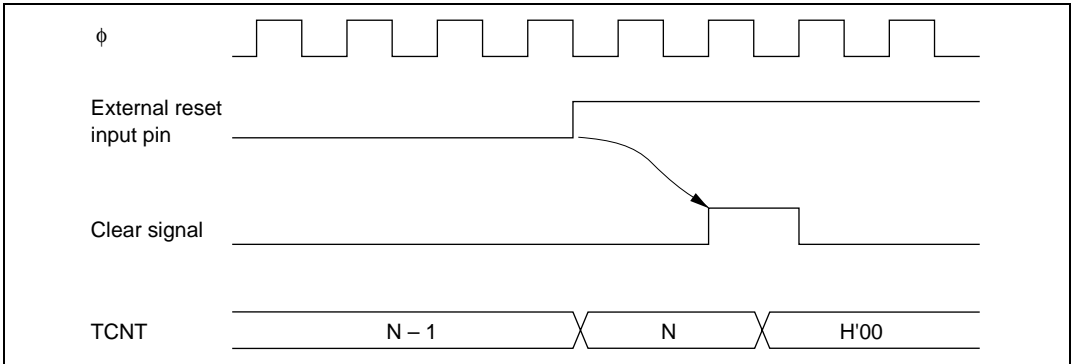


Figure 12.7 Timing of Clearing by External Reset Input

12.3.4 Timing of Overflow Flag (OVF) Setting

OVF in TCSR is set to 1 when the timer count overflows (changes from $H'FF$ to $H'00$). Figure 12.8 shows the timing of this operation.

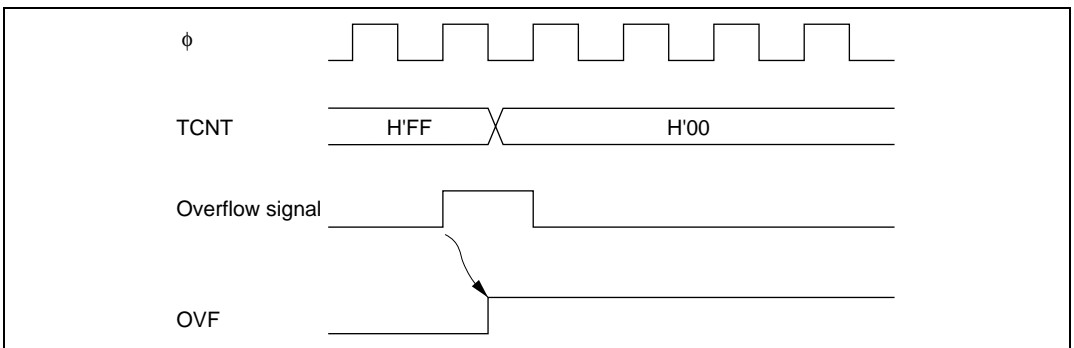


Figure 12.8 Timing of OVF Setting

12.3.5 Operation with Cascaded Connection

If bits CKS2 to CKS0 in either TCR0 or TCR1 are set to B'100, the 8-bit timers of the two channels are cascaded. With this configuration, a single 16-bit timer can be used (16-bit timer mode) or compare-matches of 8-bit channel 0 can be counted by the timer of channel 1 (compare-match count mode). In this case, the timer operates as described below.

16-Bit Count Mode: When bits CKS2 to CKS0 in TCR0 are set to B'100, the timer functions as a single 16-bit timer with channel 0 occupying the upper 8 bits and channel 1 occupying the lower 8 bits.

- Setting of compare-match flags
 - The CMF flag in TCSR0 is set to 1 when a 16-bit compare-match occurs.
 - The CMF flag in TCSR1 is set to 1 when a lower 8-bit compare-match occurs.
- Counter clear specification
 - If the CCLR1 and CCLR0 bits in TCR0 have been set for counter clear at compare-match, the 16-bit counter (TCNT0 and TCNT1 together) is cleared when a 16-bit compare-match occurs. The 16-bit counter (TCNT0 and TCNT1 together) is cleared even if counter clear by the TMRI0 pin has also been set.
 - The settings of the CCLR1 and CCLR0 bits in TCR1 are ignored. The lower 8 bits cannot be cleared independently.
- Pin output
 - Control of output from the TMO0 pin by bits OS3 to OS0 in TCSR0 is in accordance with the 16-bit compare-match conditions.
 - Control of output from the TMO1 pin by bits OS3 to OS0 in TCSR1 is in accordance with the lower 8-bit compare-match conditions.

Compare-Match Count Mode: When bits CKS2 to CKS0 in TCR1 are B'100, TCNT1 counts compare-match A's for channel 0.

Channels 0 and 1 are controlled independently. Conditions such as setting of the CMF flag, generation of interrupts, output from the TMO pin, and counter clearing are in accordance with the settings for each channel.

Usage Note: If the 16-bit count mode and compare-match count mode are set simultaneously, the input clock pulses for TCNT0 and TCNT1 are not generated and thus the counters will stop operating. Simultaneous setting of these two modes should therefore be avoided.

12.3.6 Input Capture Operation

TMRX has input capture registers of TICC, TICRR, and TICRF. Narrow pulse width can be measured with TICRR and TICRF, using one capture operation controlled by the ICST bit in the TCONRI register of the timer connection. When TMRX detects a rising and falling edge successively after the ICST bit has been set to 1, the values of TCNT at that time are transferred to TICRR and TICRF and ICST bit is cleared to 0.

The TMRX input signal can be selected by setting other bits in the TCONRI register.

(1) Input capture input timing

Figure 12.9 shows the timing of the input capture operation.

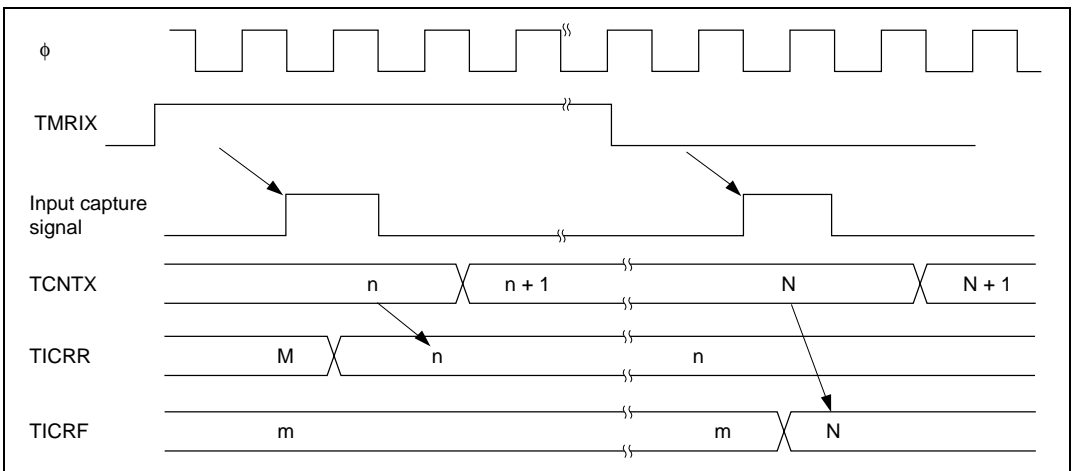
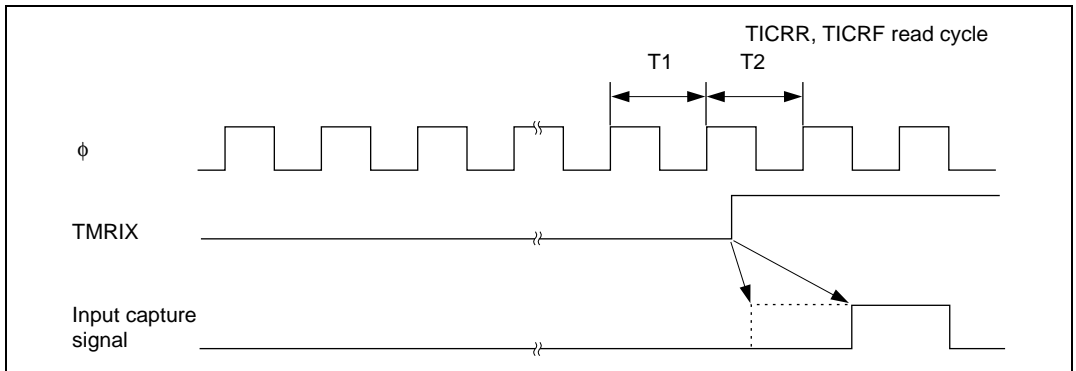


Figure 12.9 Timing of Input Capture Operation

If the input capture signal enters while TICRR and TICRF are being read, it is internally delayed one system clock (ϕ) period. Figure 12.10 shows the timing of this operation.



**Figure 12.10 Timing of Input Capture Signal
(When Input Capture Input Signal Enters while TICRR and TICRF Are Being Read)**

(2) Input capture signal input selection

Input capture input signal (TMRX) in TMRX is switched by setting bits in the TCONRI register.

Figure 12.11 and table 12.3 show the input capture signal selections.

See section 13.2.1, Timer Connection Register I (TCONRI), for details.

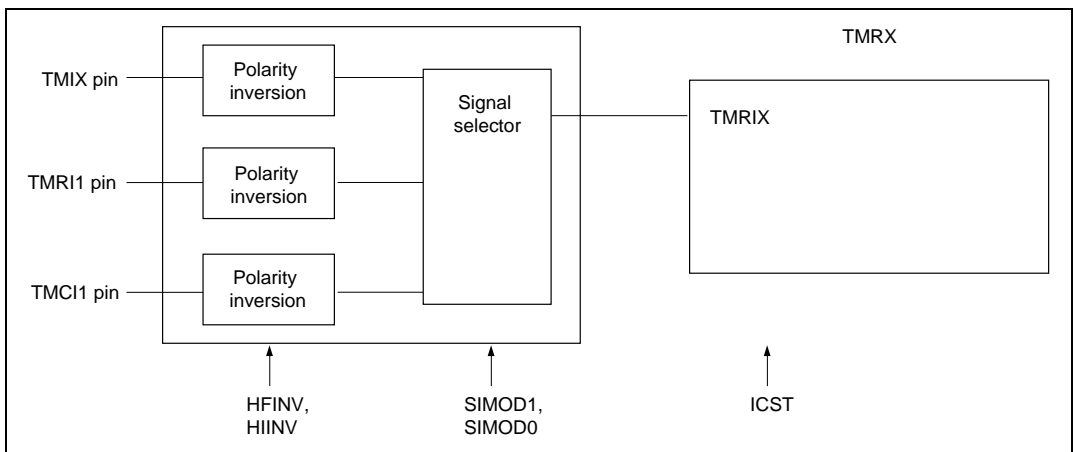


Figure 12.11 Switching of Input Capture Signal

Table 12.3 Input Capture Signal Selection

| TCONRI | | | | | Description |
|--------|--------|--------|-------|-------|------------------------------------|
| Bit 4 | Bit 7 | Bit 6 | Bit 3 | Bit 1 | |
| ICST | SIMOD1 | SIMOD0 | HFINV | HIINV | |
| 0 | — | — | — | — | Input capture function not used |
| 1 | 0 | 0 | 0 | — | TMIX pin input signal |
| | | | 1 | — | Inverted signal of TMIX pin input |
| | 1 | 1 | — | 0 | TMR11 pin input signal |
| | | | — | 1 | Inverted signal of TMR11 pin input |
| | 1 | 1 | — | 0 | TMCI1 pin input signal |
| | | | — | 1 | Inverted signal of TMCI1 pin input |

12.4 Interrupt Sources

The TMR0, TMR1, and TMRY 8-bit timers can generate three types of interrupt: compare-match A and B (CMIA and CMIB), and overflow (OVI). TMRX can generate only an ICIX interrupt. An interrupt is requested when the corresponding interrupt enable bit is set in TCR or TCSR.

Independent signals are sent to the interrupt controller for each interrupt. It is also possible to activate the DTC by means of CMIA and CMIB interrupts from TMR0, TMR1, and TMRY.

An overview of 8-bit timer interrupt sources is given in tables 12.4 to 12.6.

Table 12.4 TMR0 and TMR1 8-Bit Timer Interrupt Sources

| Interrupt source | Description | DTC Activation | Interrupt Priority |
|------------------|-------------------|----------------|--------------------|
| CMIA | Requested by CMFA | Possible | High |
| CMIB | Requested by CMFB | Possible | ↑ |
| OVI | Requested by OVF | Not possible | Low |

Table 12.5 TMRX 8-Bit Timer Interrupt Source

| Interrupt source | Description | DTC Activation |
|------------------|------------------|----------------|
| ICIX | Requested by ICF | Not possible |

Table 12.6 TMRY 8-Bit Timer Interrupt Sources

| Interrupt source | Description | DTC Activation | Interrupt Priority |
|------------------|-------------------|----------------|--------------------|
| CMIA | Requested by CMFA | Possible | High |
| CMIB | Requested by CMFB | Possible | ↑ |
| OVI | Requested by OVF | Not possible | Low |

12.5 8-Bit Timer Application Example

In the example below, the 8-bit timer is used to generate a pulse output with a selected duty cycle, as shown in figure 12.12. The control bits are set as follows:

- In TCR, CCLR1 is cleared to 0 and CCLR0 is set to 1 so that the timer counter is cleared by a TCORA compare-match.
- In TCSR, bits OS3 to OS0 are set to B'0110, causing 1 output at a TCORA compare-match and 0 output at a TCORB compare-match.

With these settings, the 8-bit timer provides output of pulses at a rate determined by TCORA with a pulse width determined by TCORB. No software intervention is required.

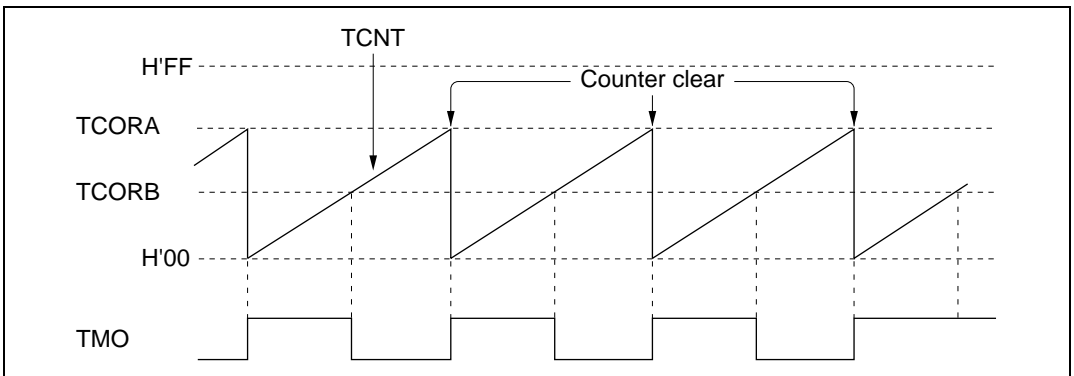


Figure 12.12 Pulse Output (Example)

12.6 Usage Notes

Application programmers should note that the following kinds of contention can occur in the 8-bit timer module.

12.6.1 Contention between TCNT Write and Clear

If a timer counter clock pulse is generated during the T2 state of a TCNT write cycle, the clear takes priority, so that the counter is cleared and the write is not performed. Figure 12.13 shows this operation.

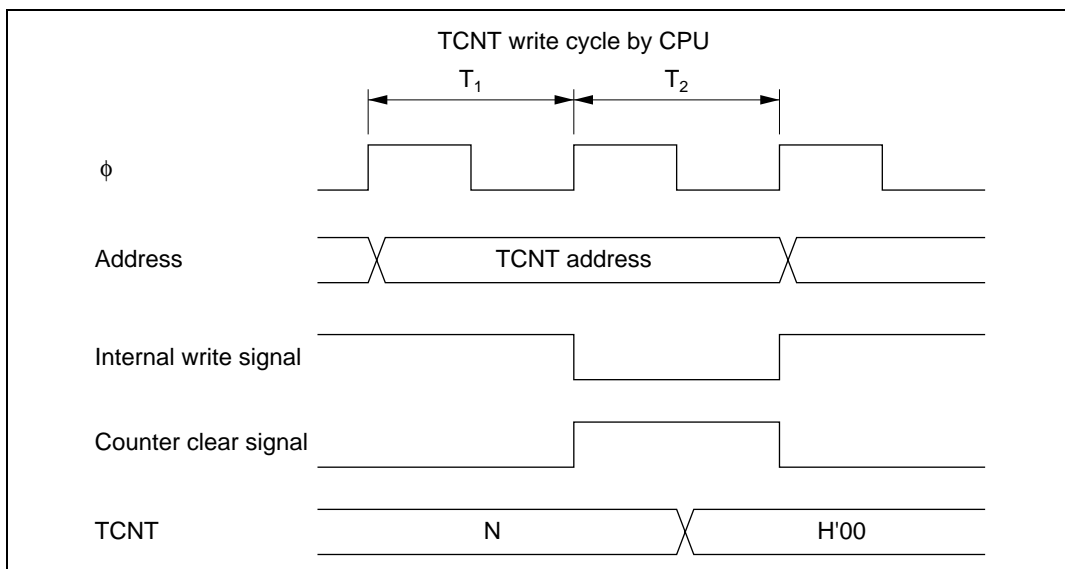


Figure 12.13 Contention between TCNT Write and Clear

12.6.2 Contention between TCNT Write and Increment

If a timer counter clock pulse is generated during the T2 state of a TCNT write cycle, the write takes priority and the counter is not incremented. Figure 12.14 shows this operation.

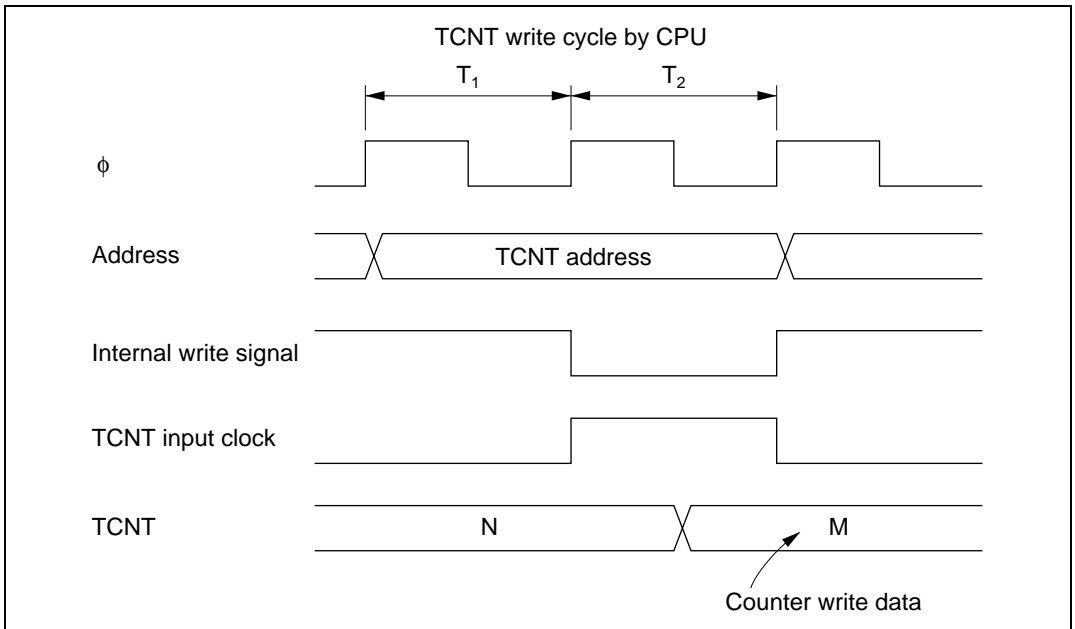


Figure 12.14 Contention between TCNT Write and Increment

12.6.3 Contention between TCOR Write and Compare-Match

During the T2 state of a TCOR write cycle, the TCOR write has priority even if a compare-match occurs and the compare-match signal is disabled. Figure 12.15 shows this operation.

With TMRX, an ICR input capture contends with a compare-match in the same way as with a write to TCORC. In this case, the input capture has priority and the compare-match signal is inhibited.

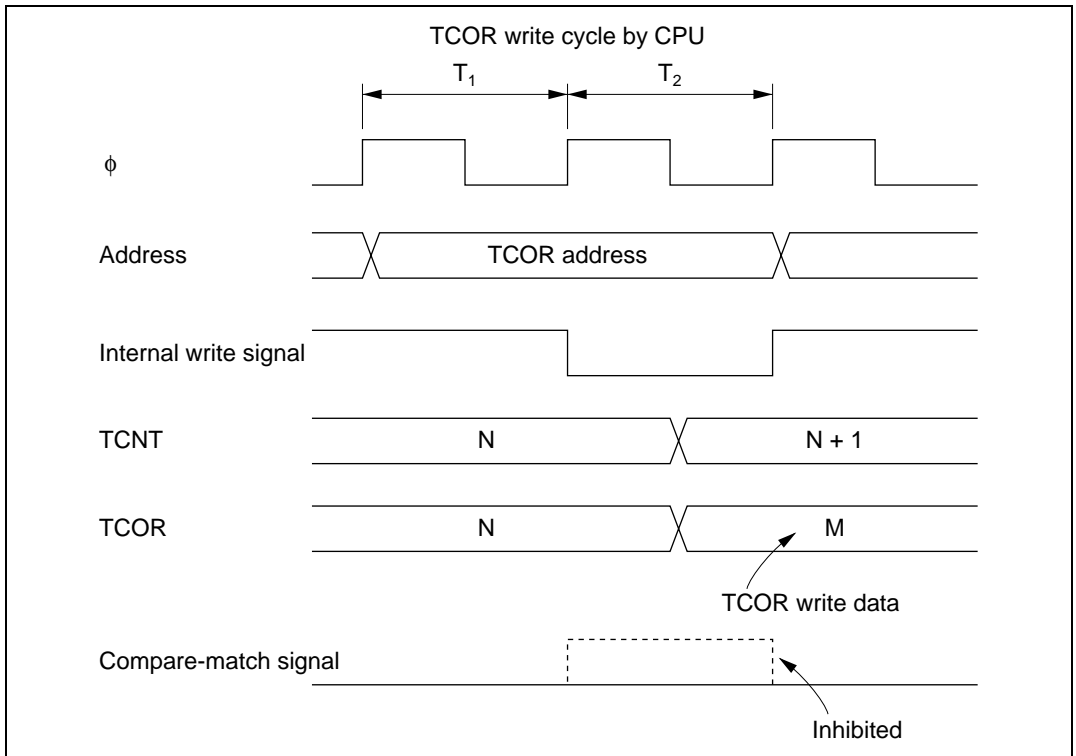


Figure 12.15 Contention between TCOR Write and Compare-Match

12.6.4 Contention between Compare-Matches A and B

If compare-matches A and B occur at the same time, the 8-bit timer operates in accordance with the priorities for the output states set for compare-match A and compare-match B, as shown in table 12.7.

Table 12.7 Timer Output Priorities

| Output Setting | Priority |
|----------------|----------|
| Toggle output | High |
| 1 output | ↑ |
| 0 output | |
| No change | Low |

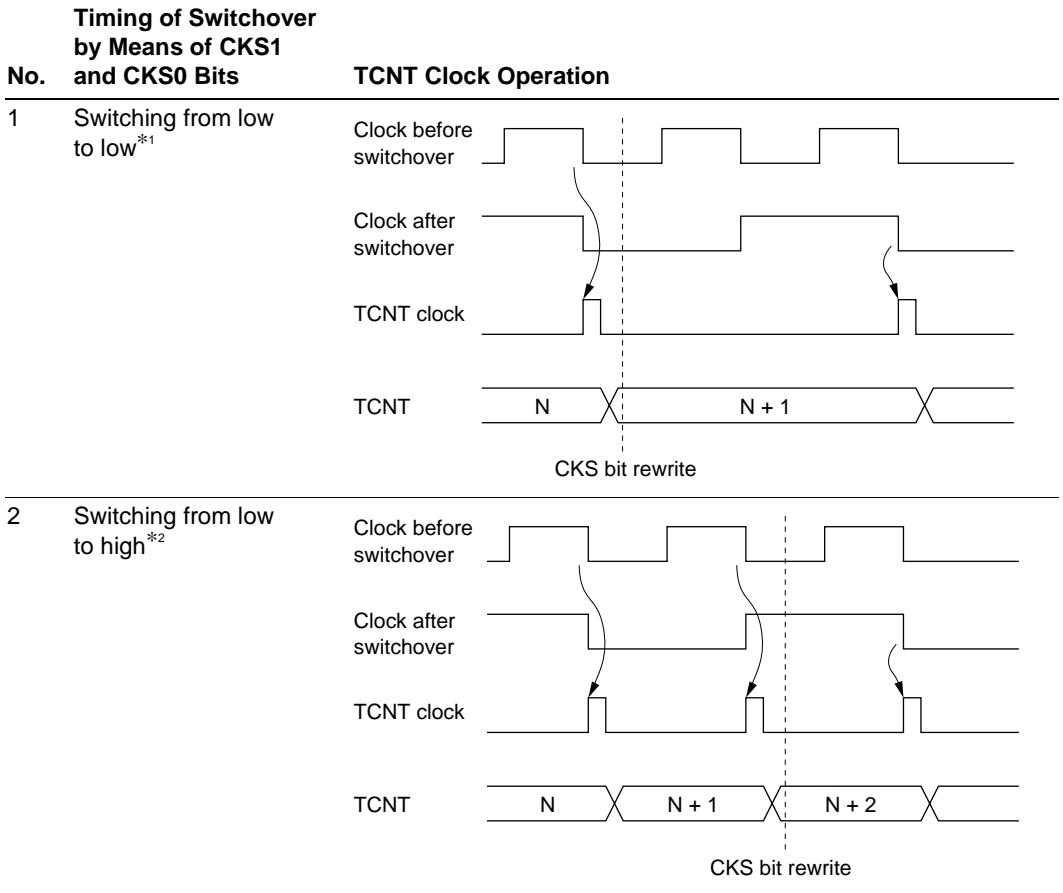
12.6.5 Switching of Internal Clocks and TCNT Operation

TCNT may increment erroneously when the internal clock is switched over. Table 12.8 shows the relationship between the timing at which the internal clock is switched (by writing to the CKS1 and CKS0 bits) and the TCNT operation

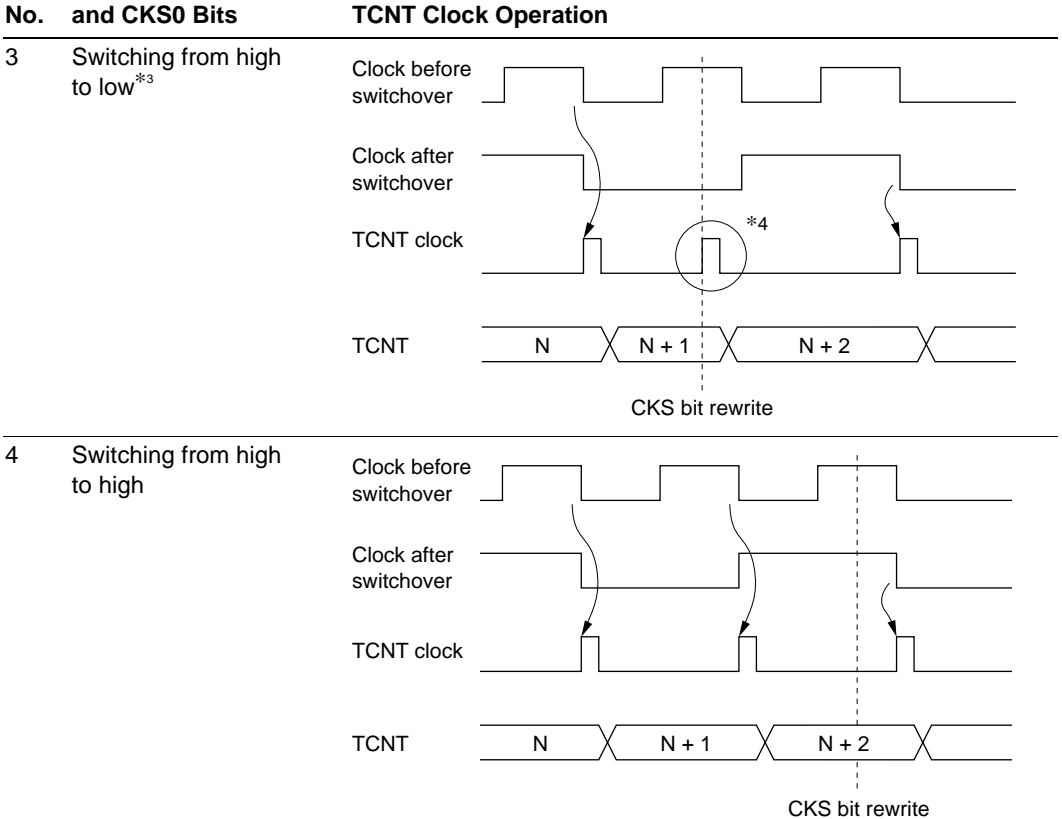
When the TCNT clock is generated from an internal clock, the falling edge of the internal clock pulse is detected. If clock switching causes a change from high to low level, as shown in no. 3 in table 12.8, a TCNT clock pulse is generated on the assumption that the switchover is a falling edge. This increments TCNT.

Erroneous incrementation can also happen when switching between internal and external clocks.

Table 12.8 Switching of Internal Clock and TCNT Operation



Timing of Switchover by Means of CKS1 and CKS0 Bits



- Notes:
1. Includes switching from low to stop, and from stop to low.
 2. Includes switching from stop to high.
 3. Includes switching from high to stop.
 4. Generated on the assumption that the switchover is a falling edge; TCNT is incremented.

Sectio 13 Timer Connection [H8S/2138 Group]

Provided in the H8S/2138 Group; not provided in the H8S/2134 Group.

13.1 Overview

The H8S/2138 Group allows interconnection between a combination of input signals, the input/output of the single free-running timer (FRT) channel and the three 8-bit timer channels (TMR1, TMRX, and TMRY). This capability can be used to implement complex functions such as PWM decoding and clamp waveform output. All the timers are initially set for independent operation.

13.1.1 Features

The features of the timer connection facility are as follows.

- Five input pins and four output pins, all of which can be designated for phase inversion. Positive logic is assumed for all signals used within the timer connection facility.
- An edge-detection circuit is connected to the input pins, simplifying signal input detection.
- TMRX can be used for PWM input signal decoding and clamp waveform generation.
- An external clock signal divided by TMR1 can be used as the FRT capture input signal.
- An internal synchronization signal can be generated using the FRT and TMRY.
- A signal generated/modified using an input signal and timer connection can be selected and output.

13.1.2 Block Diagram

Figure 13.1 shows a block diagram of the timer connection facility.

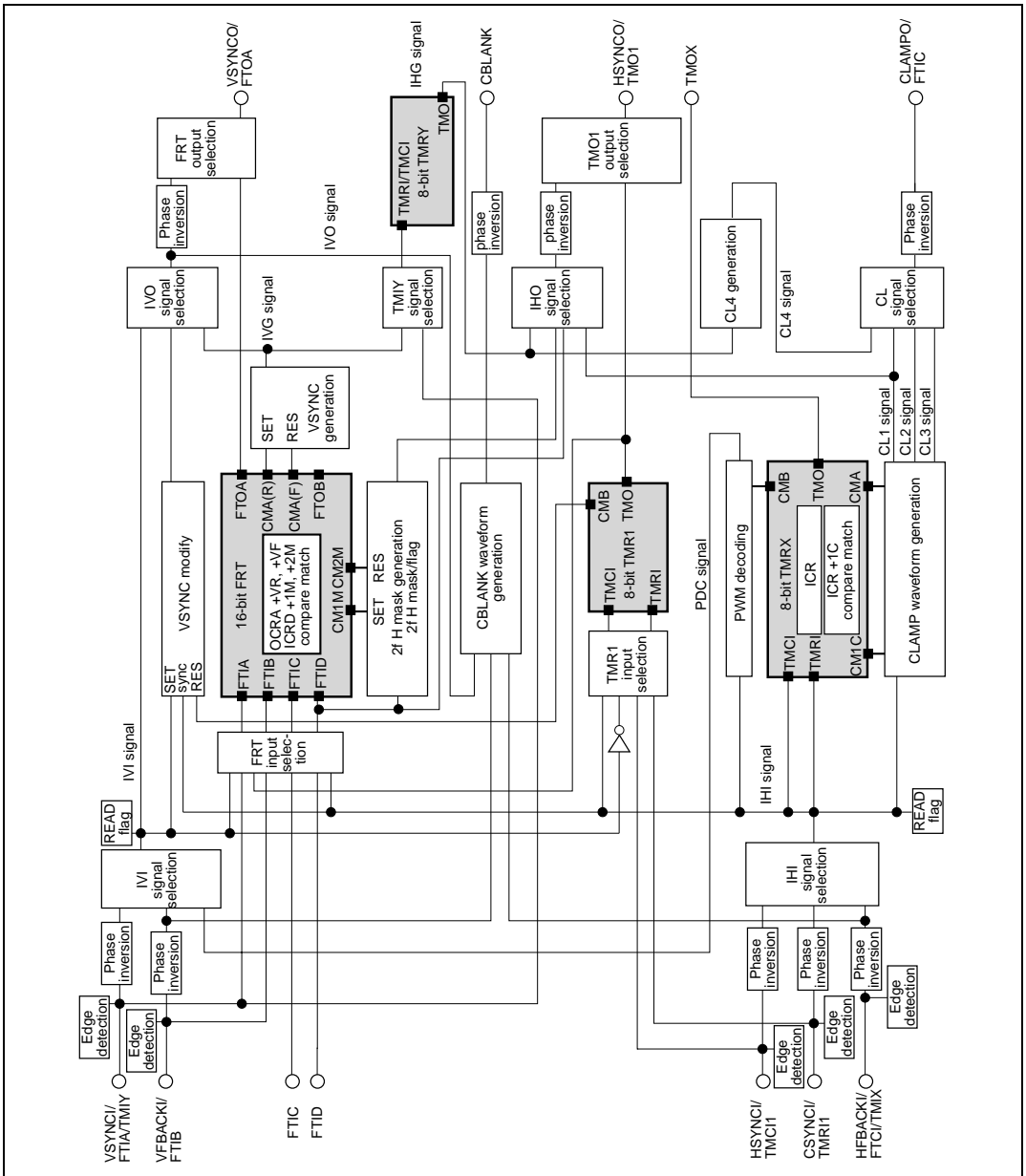


Figure 13.1 Block Diagram of Timer Connection Facility

13.1.3 Input and Output Pins

Table 13.1 lists the timer connection input and output pins.

Table 13.1 Timer Connection Input and Output Pins

| Name | Abbreviation | Input/ Output | Function |
|---|---------------------|--------------------------|--|
| Vertical synchronization signal input pin | VSYNCl | Input | Vertical synchronization signal input pin or FTIA input pin/TMIY input pin |
| Horizontal synchronization signal input pin | HSYNCl | Input | Horizontal synchronization signal input pin or TMC11 input pin |
| Composite synchronization signal input pin | CSYNCl | Input | Composite synchronization signal input pin or TMR11 input pin |
| Spare vertical synchronization signal input pin | VFBACKI | Input | Spare vertical synchronization signal input pin or FTIB input pin |
| Spare horizontal synchronization signal input pin | HFBACKI | Input | Spare horizontal synchronization signal input pin or FTCl input pin/TMIX input pin |
| Vertical synchronization signal output pin | VSYNCO | Output | Vertical synchronization signal output pin or FTOA output pin |
| Horizontal synchronization signal output pin | HSYNCO | Output | Horizontal synchronization signal output pin or TMO1 output pin |
| Clamp waveform output pin | CLAMPO | Output | Clamp waveform output pin or FTIC input pin |
| Blanking waveform output pin | CBLANK | Output | Blanking waveform output pin |

13.1.4 Register Configuration

Table 13.2 lists the timer connection registers. Timer connection registers can only be accessed when the HIE bit in SYSCR is 0.

Table 13.2 Register Configuration

| Name | Abbreviation | R/W | Initial Value | Address* ¹ |
|------------------------------|--------------|---------------------|--------------------|-----------------------|
| Timer connection register I | TCONRI | R/W | H'00 | H'FFFC |
| Timer connection register O | TCONRO | R/W | H'00 | H'FFFD |
| Timer connection register S | TCONRS | R/W | H'00 | H'FFFE |
| Edge sense register | SEDGR | R/(W)* ² | H'00* ³ | H'FFFF |
| Module stop control register | MSTPRH | R/W | H'3F | H'FF86 |
| | MSTPRL | R/W | H'FF | H'FF87 |

Notes: 1. Lower 16 bits of the address.

2. Bits 7 to 2: Only 0 can be written to clear the flags.

3. Bits 1 and 0: Undefined (reflect the pin states).

13.2 Register Descriptions

13.2.1 Timer Connection Register I (TCONRI)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|-------|------|-------|-------|-------|-------|
| | SIMOD1 | SIMOD0 | SCONE | ICST | HFINV | VFINV | HIINV | VIINV |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCONRI is an 8-bit readable/writable register that controls connection between timers, the signal source for synchronization signal input, phase inversion, etc.

TCONRI is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Input Synchronization Mode Select 1 and 0 (SIMOD1, SIMOD0): These bits select the signal source of the IHI and IVI signals.

| Bit 7 | Bit 6 | Description | | | |
|--------|--------|---------------------------|---------------|---------------|--|
| SIMOD1 | SIMOD0 | Mode | IHI Signal | IVI Signal | |
| 0 | 0 | No signal (Initial value) | HFBACKI input | VFBACKI input | |
| | 1 | S-on-G mode | CSYNCl input | PDC input | |
| 1 | 0 | Composite mode | HSYNCl input | PDC input | |
| | 1 | Separate mode | HSYNCl input | VSYNCl input | |

Bit 5—Synchronization Signal Connection Enable (SCONE): Selects the signal source of the FRT FTI input and the TMR1 TMC11/TMR11 input.

| Bit 5 | Description | | | | | | |
|-------|--|------------|-------------|---------------|------------|-------------|--------------------|
| SCONE | Mode | FTIA | FTIB | FTIC | FTID | TMC11 | TMR11 |
| 0 | Normal connection (Initial value) | FTIA input | FTIB input | FTIC input | FTID input | TMC11 input | TMR11 input |
| 1 | Synchronization signal connection mode | IVI signal | TMO1 signal | VFBACKI input | IHI signal | IHI signal | IVI inverse signal |

Bit 4—Input Capture Start Bit (ICST): The TMRX external reset input (TMR1X) is connected to the IHI signal. TMRX has input capture registers (TICR, TICRR, and TICRF). TICRR and TICRF can measure the width of a short pulse by means of a single capture operation under the control of the ICST bit. When a rising edge followed by a falling edge is detected on TMR1X after the ICST bit is set to 1, the contents of TCNT at those points are captured into TICRR and TICRF, respectively, and the ICST bit is cleared to 0.

Bit 4

| ICST | Description |
|------|---|
| 0 | The TICRR and TICRF input capture functions are stopped (Initial value) [Clearing condition] When a rising edge followed by a falling edge is detected on TMR1X |
| 1 | The TICRR and TICRF input capture functions are operating (Waiting for detection of a rising edge followed by a falling edge on TMR1X) [Setting condition] When 1 is written in ICST after reading ICST = 0 |

Bits 3 to 0—Input Synchronization Signal Inversion (HFINV, VFINV, HIINV, VIINV):

These bits select inversion of the input phase of the spare horizontal synchronization signal (HFBACKI), the spare vertical synchronization signal (VFBACKI), the horizontal synchronization signal and composite synchronization signal (HSYNCI, CSYNCI), and the vertical synchronization signal (VSYNCI).

Bit 3

| HFINV | Description |
|--------------|---|
| 0 | The HFBACKI pin state is used directly as the HFBACKI input (Initial value) |
| 1 | The HFBACKI pin state is inverted before use as the HFBACKI input |

Bit 2

| VFINV | Description |
|--------------|---|
| 0 | The VFBACKI pin state is used directly as the VFBACKI input (Initial value) |
| 1 | The VFBACKI pin state is inverted before use as the VFBACKI input |

Bit 1

| HIINV | Description |
|--------------|--|
| 0 | The HSYNCI and CSYNCI pin states are used directly as the HSYNCI and CSYNCI inputs (Initial value) |
| 1 | The HSYNCI and CSYNCI pin states are inverted before use as the HSYNCI and CSYNCI inputs |

Bit 0

| VIINV | Description |
|--------------|---|
| 0 | The VSYNCI pin state is used directly as the VSYNCI input (Initial value) |
| 1 | The VSYNCI pin state is inverted before use as the VSYNCI input |

13.2.2 Timer Connection Register 0 (TCONRO)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|------|------|-------|-------|--------|--------|
| | HOE | VOE | CLOE | CBOE | HOINV | VOINV | CLOINV | CBOINV |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCONRO is an 8-bit readable/writable register that controls output signal output, phase inversion, etc.

TCONRO is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 4—Output Enable (HOE, VOE, CLOE, CBOE): These bits control enabling/disabling of horizontal synchronization signal (HSYNCO), vertical synchronization signal (VSYNCO), clamp waveform (CLAMPO), and blanking waveform (CBLANK) output. When output is disabled, the state of the relevant pin is determined by the port DR and DDR, FRT, TMR, and PWM settings.

Output enabling/disabling control does not affect the port, FRT, or TMR input functions, but some FRT and TMR input signal sources are determined by the SCONE bit in TCONRI.

Bit 7

| HOE | Description |
|-----|--|
| 0 | The P44/TMO1/HIRQ1/HSYNCO pin functions as the P44/TMO1/HIRQ1 pin (Initial value) |
| 1 | The P44/TMO1/HIRQ1/HSYNCO pin functions as the HSYNCO pin |

Bit 6

| VOE | Description |
|-----|--|
| 0 | The P61/FTOA/ $\overline{\text{KIN1}}$ /CIN1/VSYNCO pin functions as the P61/FTOA/ $\overline{\text{KIN1}}$ /CIN1 pin (Initial value) |
| 1 | The P61/FTOA/ $\overline{\text{KIN1}}$ /CIN1/VSYNCO pin functions as the VSYNCO pin |

Bit 5

| CLOE | Description |
|-------------|--|
| 0 | The P64/FTIC/ $\overline{\text{KIN4}}$ /CIN4/CLAMPO pin functions as the P64/FTIC/ $\overline{\text{KIN4}}$ /CIN4 pin (Initial value) |
| 1 | The P64/FTIC/ $\overline{\text{KIN4}}$ /CIN4/CLAMPO pin functions as the CLAMPO pin |

Bit 4

| CBOE | Description |
|-------------|---|
| 0 | The P27/A15/PW15/CBLANK pin functions as the P27/A15/PW15 pin (Initial value) |
| 1 | In mode 1 (expanded mode with on-chip ROM disabled): The P27/A15/PW15/CBLANK pin functions as the A15 pin In modes 2 and 3 (modes with on-chip ROM enabled): The P27/A15/PW15/CBLANK pin functions as the CBLANK pin |

Bits 3 to 0—Output Synchronization Signal Inversion (HOINV, VOINV, CLOINV, CBOINV): These bits select inversion of the output phase of the horizontal synchronization signal (HSYNCO), the vertical synchronization signal (VSYNCO), the clamp waveform (CLAMPO), and the blank waveform (CBLANK).

Bit 3

| HOINV | Description |
|--------------|--|
| 0 | The IHO signal is used directly as the HSYNCO output (Initial value) |
| 1 | The IHO signal is inverted before use as the HSYNCO output |

Bit 2

| VOINV | Description |
|--------------|--|
| 0 | The IVO signal is used directly as the VSYNCO output (Initial value) |
| 1 | The IVO signal is inverted before use as the VSYNCO output |

Bit 1

| CLOINV | Description |
|---------------|--|
| 0 | The CLO signal (CL1, CL2, CL3, or CL4 signal) is used directly as the CLAMPO output (Initial value) |
| 1 | The CLO signal (CL1, CL2, CL3, or CL4 signal) is inverted before use as the CLAMPO output |

Bit 0

| CBOINV | Description |
|---------------|---|
| 0 | The CBLANK signal is used directly as the CBLANK output (Initial value) |
| 1 | The CBLANK signal is inverted before use as the CBLANK output |

13.2.3 Timer Connection Register S (TCONRS)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | TMRX/Y | ISGENE | HOMOD1 | HOMOD0 | VOMOD1 | VOMOD0 | CLMOD1 | CLMOD0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCONRS is an 8-bit readable/writable register that selects 8-bit timer TMRX/TMRY access and the synchronization signal output signal source and generation method.

TCONRS is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—TMRX/TMRY Access Select (TMRX/Y): The TMRX and TMRY registers can only be accessed when the HIE bit in SYSCR is cleared to 0. In the H8S/2138 Group, some of the TMRX registers and the TMRY registers are assigned to the same memory space addresses (H'FFF0 to H'FFF5), and the TMRX/Y bit determines which registers are accessed. In the H8S/2134 Group, there is no control of TMRY register access by this bit.

Bit 7

| TMRX/Y | Description |
|---------------|---|
| 0 | The TMRX registers are accessed at addresses H'FFF0 to H'FFF5 (Initial value) |
| 1 | The TMRY registers are accessed at addresses H'FFF0 to H'FFF5 |

Bit 6—Internal Synchronization Signal Select (ISGENE): Selects internal synchronization signals (IHG, IVG, and CL4 signals) as the signal sources for the IHO, IVO, and CLO signals.

Bits 5 and 4—Horizontal Synchronization Output Mode Select 1 and 0 (HOMOD1, HOMOD0): These bits select the signal source and generation method for the IHO signal.

| Bit 6 | Bit 5 | Bit 4 | Description |
|--------|--------|--------|---|
| ISGENE | VOMOD1 | VOMOD0 | |
| 0 | 0 | 0 | The IHI signal (without 2fH modification) is selected (Initial value) |
| | | 1 | The IHI signal (with 2fH modification) is selected |
| | 1 | 0 | The CL1 signal is selected |
| | | 1 | |
| 1 | 0 | 0 | The IHG signal is selected |
| | | 1 | |
| | 1 | 0 | |
| | | 1 | |

Bits 3 and 2—Vertical Synchronization Output Mode Select 1 and 0 (VOMOD1, VOMOD0): These bits select the signal source and generation method for the IVO signal.

| Bit 6 | Bit 3 | Bit 2 | Description |
|--------|--------|--------|---|
| ISGENE | VOMOD1 | VOMOD0 | |
| 0 | 0 | 0 | The IVI signal (without fall modification or IHI synchronization) is selected (Initial value) |
| | | 1 | The IVI signal (without fall modification, with IHI synchronization) is selected |
| | 1 | 0 | The IVI signal (with fall modification, without IHI synchronization) is selected |
| | | 1 | The IVI signal (with fall modification and IHI synchronization) is selected |
| 1 | 0 | 0 | The IVG signal is selected |
| | | 1 | |
| | 1 | 0 | |
| | | 1 | |

Bits 1 and 0—Clamp Waveform Mode Select 1 and 0 (CLMOD1, CLMOD0): These bits select the signal source for the CLO signal (clamp waveform).

| Bit 6 | Bit 1 | Bit 0 | Description |
|-------|-------|-------|----------------------------|
| 0 | 0 | 0 | The CL1 signal is selected |
| | | 1 | The CL2 signal is selected |
| | 1 | 0 | The CL3 signal is selected |
| | | 1 | |
| 1 | 0 | 0 | The CL4 signal is selected |
| | | 1 | |
| | 1 | 0 | |
| | | 1 | |

13.2.4 Edge Sense Register (SEDGR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---------|---------|---------|---------|---------|---------|-----|-----|
| | VEDG | HEDG | CEDG | HFEDG | VFEDG | PREQF | IHI | IVI |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | —*2 | —*2 |
| Read/Write | R/(W)*1 | R/(W)*1 | R/(W)*1 | R/(W)*1 | R/(W)*1 | R/(W)*1 | R | R |

- Notes:
1. Only 0 can be written, to clear the flags.
 2. The initial value is undefined since it depends on the pin states.

SEDGR is an 8-bit readable/writable register used to detect a rising edge on the timer connection input pins and the occurrence of 2fH modification, and to determine the phase of the IVI and IHI signals.

The upper 6 bits of SEDGR are initialized to 0 by a reset and in hardware standby mode. The initial value of the lower 2 bits is undefined, since it depends on the pin states.

Bit 7—VSYNCl Edge (VEDG): Detects a rising edge on the VSYNCl pin.

Bit 7

| VEDG | Description |
|------|--|
| 0 | [Clearing condition] (Initial value) When 0 is written in VEDG after reading VEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the VSYNCl pin |

Bit 6—HSYNCl Edge (HEDG): Detects a rising edge on the HSYNCl pin.

Bit 6

| HEDG | Description |
|------|--|
| 0 | [Clearing condition] (Initial value) When 0 is written in HEDG after reading HEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the HSYNCl pin |

Bit 5—CSYNCl Edge (CEDG): Detects a rising edge on the CSYNCl pin.

Bit 5

| CEDG | Description |
|------|--|
| 0 | [Clearing condition] (Initial value) When 0 is written in CEDG after reading CEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the CSYNCl pin |

Bit 4—HFBACKI Edge (HFEDG): Detects a rising edge on the HFBACKI pin.

Bit 4

| HFEDG | Description |
|-------|--|
| 0 | [Clearing condition] (Initial value) When 0 is written in HFEDG after reading HFEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the HFBACKI pin |

Bit 3—VFBACKI Edge (VFEDG): Detects a rising edge on the VFBACKI pin.

Bit 3

| VFEDG | Description |
|-------|--|
| 0 | [Clearing condition] (Initial value) When 0 is written in VFEDG after reading VFEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the VFBACKI pin |

Bit 2—Pre-Equalization Flag (PREQF): Detects the occurrence of an IHI signal 2fH modification condition. The generation of a falling/rising edge in the IHI signal during a mask interval is expressed as the occurrence of a 2fH modification condition. For details, see section 13.3.4, IHI Signal and 2fH Modification.

Bit 2

| PREQF | Description |
|-------|--|
| 0 | [Clearing condition] (Initial value) When 0 is written in PREQF after reading PREQF = 1 |
| 1 | [Setting condition] When an IHI signal 2fH modification condition is detected |

Bit 1—IHI Signal Level (IHI): Indicates the current level of the IHI signal. Signal source and phase inversion selection for the IHI signal depends on the contents of TCONRI. Read this bit to determine whether the input signal is positive or negative, then maintain the IHI signal at positive phase by modifying TCONRI.

Bit 1

| IHI | Description |
|-----|------------------------|
| 0 | The IHI signal is low |
| 1 | The IHI signal is high |

Bit 0—IVI Signal Level (IVI): Indicates the current level of the IVI signal. Signal source and phase inversion selection for the IVI signal depends on the contents of TCONRI. Read this bit to determine whether the input signal is positive or negative, then maintain the IVI signal at positive phase by modifying TCONRI.

Bit 0

| IVI | Description |
|-----|------------------------|
| 0 | The IVI signal is low |
| 1 | The IVI signal is high |

13.2.5 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When the MSTP13, MSTP12, and MSTP8 bits are set to 1, the 16-bit free-running timer, 8-bit timer channels 0 and 1, and 8-bit timer channels X and Y and timer connection, respectively, halt and enter module stop mode. See section 24.5, Module Stop Mode, for details.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 5—Module Stop (MSTP13): Specifies FRT module stop mode.

MSTPCRH**Bit 5**

| MSTP13 | Description |
|--------|---|
| 0 | FRT module stop mode is cleared |
| 1 | FRT module stop mode is set (Initial value) |

MSTPCRH Bit 4—Module Stop (MSTP12): Specifies 8-bit timer channel 0 and 1 module stop mode.

MSTPCRH

Bit 4

| MSTP12 | Description |
|--------|---|
| 0 | 8-bit timer channel 0 and 1 module stop mode is cleared |
| 1 | 8-bit timer channel 0 and 1 module stop mode is set (Initial value) |

MSTPCRH Bit 0—Module Stop (MSTP8): Specifies 8-bit timer channel X and Y and timer connection module stop mode.

MSTPCRH

Bit 0

| MSTP8 | Description |
|-------|--|
| 0 | 8-bit timer channel X and Y and timer connection module stop mode is cleared |
| 1 | 8-bit timer channel X and Y and timer connection module stop mode is set (Initial value) |

13.3 Operation

13.3.1 PWM Decoding (PDC Signal Generation)

The timer connection facility and TMRX can be used to decode a PWM signal in which 0 and 1 are represented by the pulse width. To do this, a signal in which a rising edge is generated at regular intervals must be selected as the IHI signal.

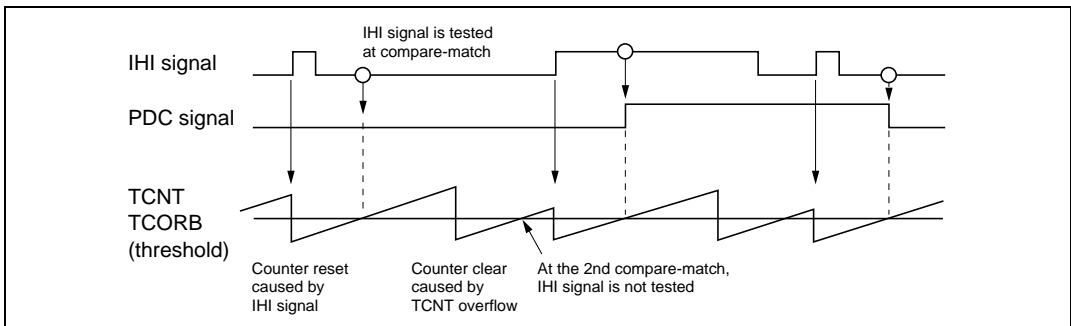
The timer counter (TCNT) in TMRX is set to count the internal clock pulses and to be cleared on the rising edge of the external reset signal (IHI signal). The value to be used as the threshold for deciding the pulse width is written in TCORB. The PWM decoder contains a delay latch which uses the IHI signal as data and compare-match signal B (CMB) as a clock, and the state of the IHI signal (the result of the pulse width decision) at the compare-match signal B timing after TCNT is reset by the rise of the IHI signal is output as the PDC signal. The pulse width setting using TICRR and TICRF of TMRX can be used to determine the pulse width decision threshold. Examples of TCR and TCORB settings are shown in tables 13.3 and 13.4, and the timing chart is shown in figure 13.2.

Table 13.3 Examples of TCR Settings

| Bit(s) | Abbreviation | Contents | Description |
|---------|--------------|----------|--|
| 7 | CMIEB | 0 | Interrupts due to compare-match and overflow are disabled |
| 6 | CMIEA | 0 | |
| 5 | OVIE | 0 | |
| 4 and 3 | CCLR1, CCLR0 | 11 | TCNT is cleared by the rising edge of the external reset signal (IHI signal) |
| 2 to 0 | CKS2 to CKS0 | 001 | Incremented on internal clock: ϕ |

Table 13.4 Examples of TCORB (Pulse Width Threshold) Settings

| | ϕ :10 MHz | ϕ : 12 MHz | ϕ : 16 MHz | ϕ : 20 MHz |
|------|----------------|-----------------|-----------------|-----------------|
| H'07 | 0.8 μ s | 0.67 μ s | 0.5 μ s | 0.4 μ s |
| H'0F | 1.6 μ s | 1.33 μ s | 1 μ s | 0.8 μ s |
| H'1F | 3.2 μ s | 2.67 μ s | 2 μ s | 1.6 μ s |
| H'3F | 6.4 μ s | 5.33 μ s | 4 μ s | 3.2 μ s |
| H'7F | 12.8 μ s | 10.67 μ s | 8 μ s | 6.4 μ s |

**Figure 13.2 Timing Chart for PWM Decoding**

13.3.2 Clamp Waveform Generation (CL1/CL2/CL3 Signal Generation)

The timer connection facility and TMRX can be used to generate signals with different duty cycles and rising/falling edges (clamp waveforms) in synchronization with the input signal (IHI signal). Three clamp waveforms can be generated: the CL1, CL2, and CL3 signals. In addition, the CL4 signal can be generated using TMRY.

The CL1 signal rises simultaneously with the rise of the IHI signal, and when the CL1 signal is high, the CL2 signal rises simultaneously with the fall of the IHI signal. The fall of both the CL1 and the CL2 signal can be specified by TCORA.

The rise of the CL3 signal can be specified as simultaneous with the sampling of the fall of the IHI signal using the system clock, and the fall of the CL3 signal can be specified by TCORC. The CL3 signal can also fall when the IHI signal rises.

TCNT in TMRX is set to count internal clock pulses and to be cleared on the rising edge of the external reset signal (IHI signal).

The value to be used as the CL1 signal pulse width is written in TCORA. Write a value of H'02 or more in TCORA when internal clock ϕ is selected as the TMRX counter clock, and a value of H'01 or more when $\phi/2$ is selected. When internal clock ϕ is selected, the CL1 signal pulse width is (TCORA set value + 3 \pm 0.5). When the CL2 signal is used, the setting must be made so that this pulse width is greater than the IHI signal pulse width.

The value to be used as the CL3 signal pulse width is written in TCORC. The TICR register in TMRX captures the value of TCNT at the inverse of the external reset signal edge (in this case, the falling edge of the IHI signal). The timing of the fall of the CL3 signal is determined by the sum of the contents of TICR and TCORC. Caution is required if the rising edge of the IHI signal precedes the fall timing set by the contents of TCORC, since the IHI signal will cause the CL3 signal to fall.

Examples of TMRX TCR settings are the same as those in table 13.3. The clamp waveform timing charts are shown in figures 13.3 and 13.4.

Since the rise of the CL1 and CL2 signals is synchronized with the edge of the IHI signal, and their fall is synchronized with the system clock, the pulse width variation is equivalent to the resolution of the system clock.

Both the rise and the fall of the CL3 signal are synchronized with the system clock and the pulse width is fixed, but there is a variation in the phase relationship with the IHI signal equivalent to the resolution of the system clock.

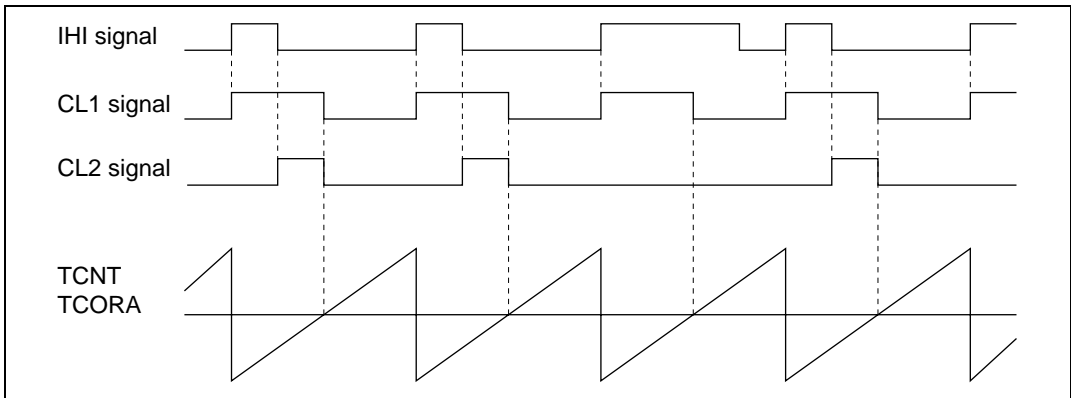


Figure 13.3 Timing Chart for Clamp Waveform Generation (CL1 and CL2 Signals)

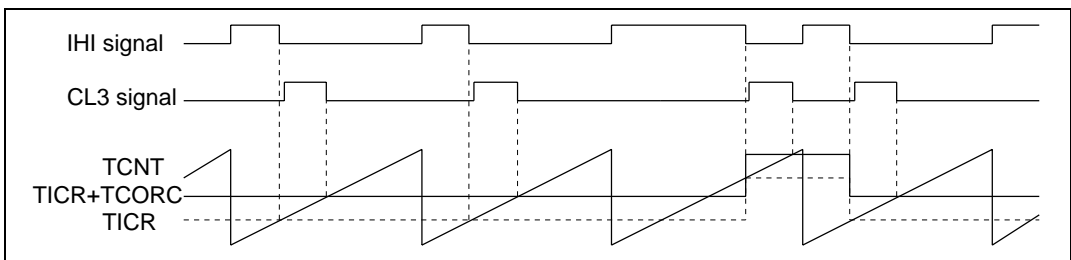


Figure 13.4 Timing Chart for Clamp Waveform Generation (CL3 Signal)

13.3.3 Measurement of 8-Bit Timer Divided Waveform Period

The timer connection facility, TMR1, and the free-running timer (FRT) can be used to measure the period of an IHI signal divided waveform. Since TMR1 can be cleared by a rising edge of inverted IVI signal, the rise and fall of the IHI signal divided waveform can be virtually synchronized with the IVI signal. This enables period measurement to be carried out efficiently.

To measure the period of an IHI signal divided waveform, TCNT in TMR1 is set to count the external clock (IHI signal) pulses and to be cleared on the rising edge of the external reset signal (inverted IVI signal). The value to be used as the division factor is written in TCORA, and the TMO output method is specified by the OS bits in TCSR. Examples of TCR and TCSR settings are shown in table 13.5, and the timing chart for measurement of the IVI signal and IHI signal divided waveform periods is shown in figure 13.5. The period of the IHI signal divided waveform is given by $(ICRD(3) - ICRD(2)) \times$ the resolution.

Table 13.5 Examples of TCR and TCSR Settings

| Register | Bit(s) | Abbreviation | Contents | Description |
|--------------|---------|--------------|----------|--|
| TCR in TMR1 | 7 | CMIEB | 0 | Interrupts due to compare-match and overflow are disabled |
| | 6 | CMIEA | 0 | |
| | 5 | OVIE | 0 | |
| | 4 and 3 | CCLR1, CCLR0 | 11 | TCNT is cleared by the rising edge of the external reset signal (inverted IVI signal) |
| | 2 to 0 | CKS2 to CKS0 | 101 | TCNT is incremented on the rising edge of the external clock (IHI signal) |
| TCSR in TMR1 | 3 to 0 | OS3 to OS0 | 0011 | Not changed by compare-match B; output inverted by compare-match A (toggle output): division by 512 |
| | | | 1001 | or when TCORB < TCORA, 1 output on compare-match B, and 0 output on compare-match A: division by 256 |
| TCR in FRT | 6 | IEDGB | 0/1 | 0: FRC value is transferred to ICRB on falling edge of input capture input B (IHI divided signal waveform) |
| | | | | 1: FRC value is transferred to ICRB on rising edge of input capture input B (IHI divided signal waveform) |
| | 1 and 0 | CKS1, CKS0 | 01 | FRC is incremented on internal clock: $\phi/8$ |
| TCSR in FRT | 0 | CCLRA | 0 | FRC clearing is disabled |

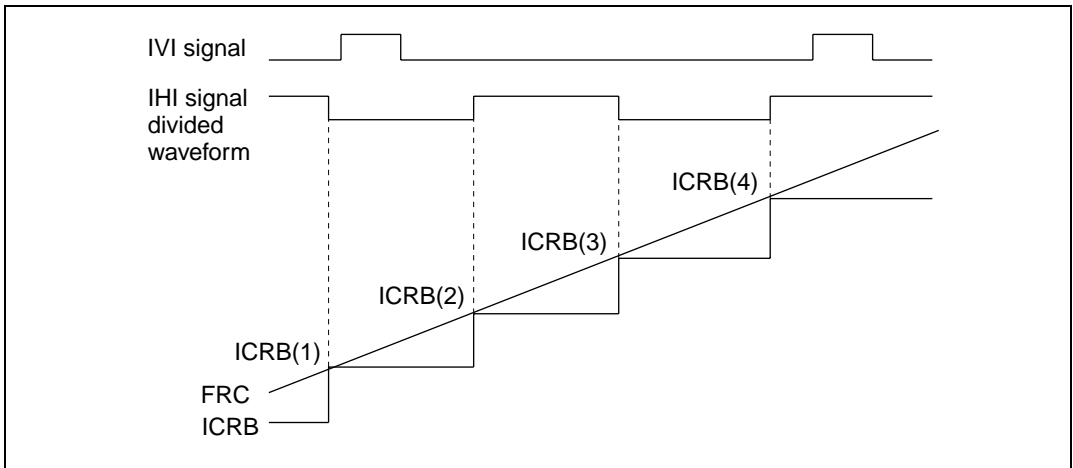


Figure 13.5 Timing Chart for Measurement of IVI Signal and IHI Signal Divided Waveform Periods

13.3.4 IHI Signal and 2fH Modification

By using the timer connection FRT, even if there is a part of the IHI signal with twice the frequency, this can be eliminated. In order for this function to operate properly, the duty cycle of the IHI signal must be approximately 30% or less, or approximately 70% or above.

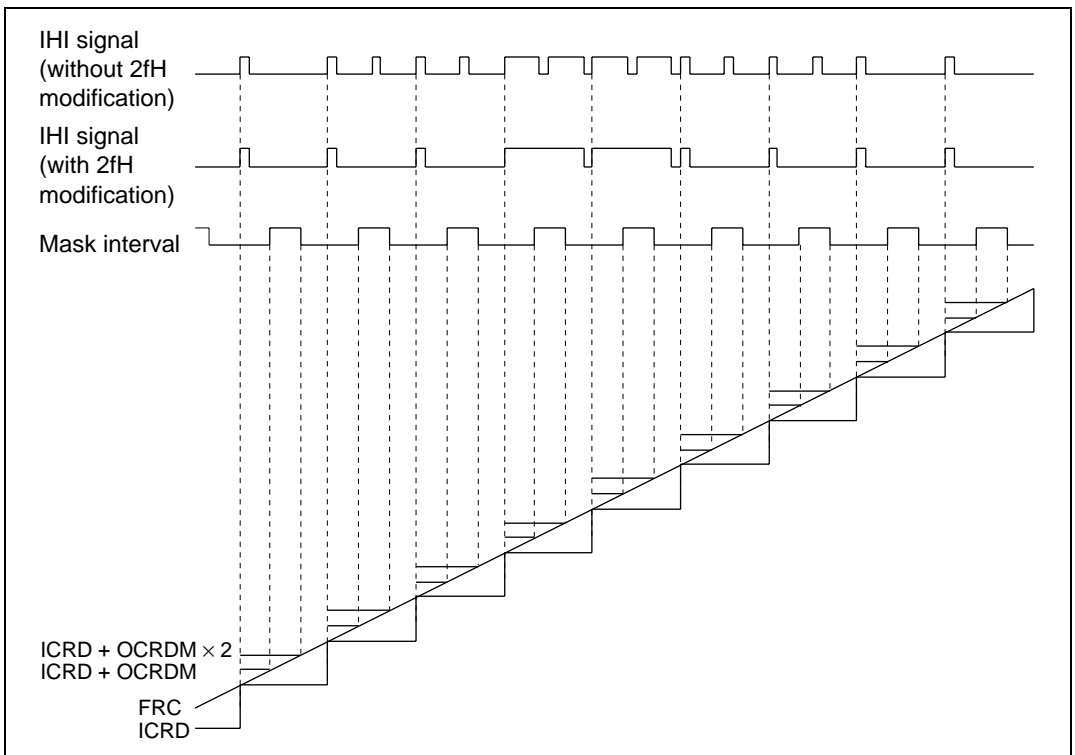
The 8-bit OCRDM contents or twice the OCRDM contents can be added automatically to the data captured in ICRD in the FRT, and compare-matches generated at these points. The interval between the two compare-matches is called a mask interval. A value equivalent to approximately 1/3 the IHI signal period is written in OCRDM. ICRD is set so that capture is performed on the rise of the IHI signal.

Since the IHI signal supplied to the IHO signal selection circuit is normally set on the rise of the IHI signal and reset on the fall, its waveform is the same as that of the original IHI signal. When 2fH modification is selected, IHI signal edge detection is disabled during mask intervals. Capture is also disabled during these intervals.

Examples of FRT TCR settings are shown in table 13.6, and the 2fH modification timing chart is shown in figure 13.6.

Table 13.6 Examples of TCR, TCSR, TCOR, and OCRDM Settings

| Register | Bit(s) | Abbreviation | Contents | Description |
|--------------|---------|------------------|--------------|---|
| TCR in FRT | 4 | IEDGD | 1 | FRC value is transferred to ICRD on the rising edge of input capture input D (IHI signal) |
| | 1 and 0 | CKS1, CKS0 | 01 | FRC is incremented on internal clock: $\phi/8$ |
| TCSR in FRT | 0 | CCLRA | 0 | FRC clearing is disabled |
| TCOR in FRT | 7 | ICRDMS | 1 | ICRD is set to the operating mode in which OCRDM is used |
| OCRDM in FRT | 7 to 0 | OCRDM7 to OCRDM0 | H'01 to H'FF | Specifies the period during which ICRD operation is masked |

**Figure 13.6 2fH Modification Timing Chart**

13.3.5 IVI Signal Fall Modification and IHI Synchronization

By using the timer connection TMR1, the fall of the IVI signal can be shifted backward by the specified number of IHI signal waveforms. Also, the fall of the IVI signal can be synchronized with the rise of the IHI signal.

To perform 8-bit timer divided waveform period measurement, TCNT in TMR1 is set to count external clock (IHI signal) pulses, and to be cleared on the rising edge of the external reset signal (inverse of the IVI signal). The number of IHI signal pulses until the fall of the IVI signal is written in TCORB.

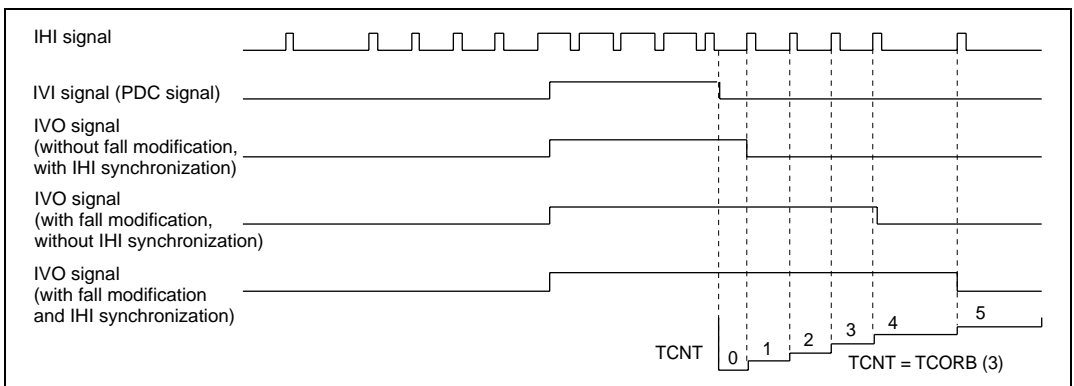
Since the IVI signal supplied to the IVO signal selection circuit is normally set on the rise of the IVI signal and reset on the fall, its waveform is the same as that of the original IVI signal. When fall modification is selected, a reset is performed on a TMR1 TCORB compare-match.

The fall of the waveform generated in this way can be synchronized with the rise of the IHI signal, regardless of whether or not fall modification is selected.

Examples of TMR1 TCORB, TCR, and TCSR settings are shown in table 13.7, and the fall modification/IHI synchronization timing chart is shown in figure 13.7.

Table 13.7 Examples of TCORB, TCR, and TCSR Settings

| Register | Bit(s) | Abbreviation | Contents | Description |
|---------------|---------|--------------|----------------|---|
| TCR in TMR1 | 7 | CMIEB | 0 | Interrupts due to compare-match and overflow are disabled |
| | 6 | CMIEA | 0 | |
| | 5 | OVIE | 0 | |
| | 4 and 3 | CCLR1, CCLR0 | 11 | TCNT is cleared by the rising edge of the external reset signal (inverse of the IVI signal) |
| | 2 to 0 | CKS2 to CKS0 | 101 | TCNT is incremented on the rising edge of the external clock (IHI signal) |
| TCSR in TMR1 | 3 to 0 | OS3 to OS0 | 0011 | Not changed by compare-match B; output inverted by compare-match A (toggle output) |
| | | | 1001 | or when $TCORB \leq TCORA$, 1 output on compare-match B, 0 output on compare-match A |
| TOCRB in TMR1 | | | H'03 (example) | Compare-match on the 4th (example) rise of the IHI signal after the rise of the inverse of the IVI signal |

**Figure 13.7 Fall Modification/IHI Synchronization Timing Chart**

13.3.6 Internal Synchronization Signal Generation (IHG/IVG/CL4 Signal Generation)

By using the timer connection FRT and TMRY, it is possible to automatically generate internal signals (IHG and IVG signals) corresponding to the IHI and IVI signals. As the IHG signal is synchronized with the rise of the IVG signal, the IHG signal period must be made a divisor of the IVG signal period in order to keep it constant. In addition, the CL4 signal can be generated in synchronization with the IHG signal.

The contents of OCRA in the FRT are updated by the automatic addition of the contents of OCRAR or OCRAF, alternately, each time a compare-match occurs. A value corresponding to the 0 interval of the IVG signal is written in OCRAR, and a value corresponding to the 1 interval of the IVG signal is written in OCRAF. The IVG signal is set by a compare-match after an OCRAR addition, and reset by a compare-match after an OCRAF addition.

The IHG signal is the TMRY 8-bit timer output. TMRY is set to count internal clock pulses, and to be cleared on TCORA compare-match, to fix the period and set the timer output. TCORB is set so as to reset the timer output. The IVG signal is connected as the TMRY reset input (TMRI), and the rise of the IVG signal can be treated in the same way as a TCORA compare-match.

The CL4 signal is a waveform that rises within one system clock period after the fall of the IHG signal, and has a 1 interval of 6 system clock periods.

Examples of settings of TCORA, TCORB, TCR, and TCSR in TMRY, and OCRAR, OCRAF, and TCR in the FRT, are shown in table 13.8, and the IHG signal/IVG signal timing chart is shown in figure 13.8.

Table 13.8 Examples of OCRAR, OCRAF, TOCR, TCORA, TCORB, TCR, and TCSR Settings

| Register | Bit(s) | Abbreviation | Contents | Description | |
|---------------|---------|--------------|------------------|---|--|
| TCR in TMRY | 7 | CMIEB | 0 | Interrupts due to compare-match and overflow are disabled | |
| | 6 | CMIEA | 0 | | |
| | 5 | OVIE | 0 | | |
| | 4 and 3 | CCLR1, CCLR0 | 01 | TCNT is cleared by compare-match A | |
| | 2 to 0 | CKS2 to CKS0 | 001 | TCNT is incremented on internal clock: $\phi/4$ | |
| TCSR in TMRY | 3 to 0 | OS3 to OS0 | 0110 | 0 output on compare-match B 1 output on compare-match A | |
| TOCRA in TMRY | | | H'3F (example) | IHG signal period = $\phi \times 256$ | |
| TOCRB in TMRY | | | H'03 (example) | IHG signal 1 interval = $\phi \times 16$ | |
| TCR in FRT | 1 and 0 | CKS1, CKS0 | 01 | FRC is incremented on internal clock: $\phi/8$ | |
| OCRAR in FRT | | | H'7FEF (example) | IVG signal 0 interval = $\phi \times 262016$ | IVG signal period = $\phi \times 262144$ (1024 times IHG signal) |
| OCRAF in FRT | | | H'000F (example) | IVG signal 1 interval = $\phi \times 128$ | |
| TOCR in FRT | 6 | OCRAMS | 1 | OCRA is set to the operating mode in which OCRAR and OCRAF are used | |

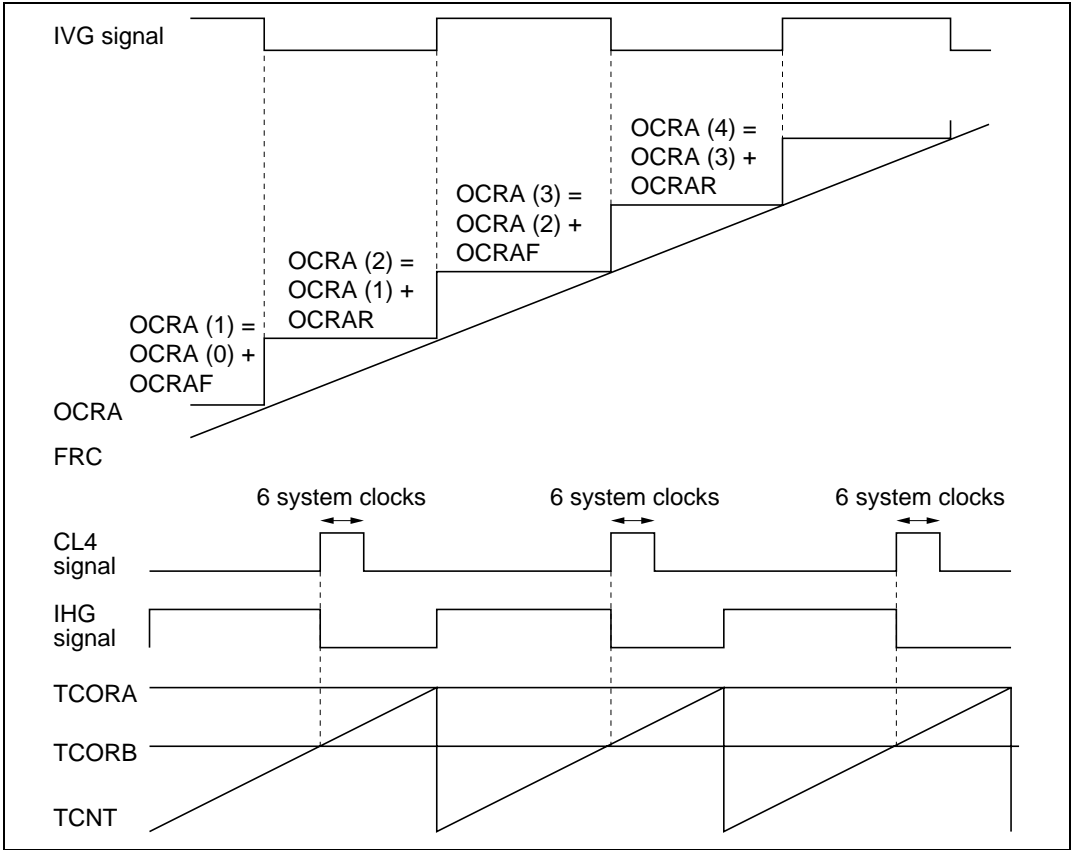


Figure 13.8 IVG Signal/IHG Signal/CL4 Signal Timing Chart

13.3.7 HSYNCO Output

With the HSYNCO output, the meaning of the signal source to be selected and use or non-use of modification varies according to the IHI signal source and the waveform required by external circuitry. The meaning of the HSYNCO output in each mode is shown in table 13.9.

Table 13.9 Meaning of HSYNCO Output in Each Mode

| Mode | IHI Signal | IHO Signal | Meaning of IHO Signal |
|----------------|---------------|---------------------------------------|---|
| No signal | HFBACKI input | IHI signal (without 2fH modification) | HFBACKI input is output directly |
| | | IHI signal (with 2fH modification) | Meaningless unless there is a double-frequency part in the HFBACKI input |
| | | CL1 signal | HFBACKI input 1 interval is changed before output |
| | | IHG signal | Internal synchronization signal is output |
| S-on-G mode | CSYNCI input | IHI signal (without 2fH modification) | CSYNCI input (composite synchronization signal) is output directly |
| | | IHI signal (with 2fH modification) | Double-frequency part of CSYNCI input (composite synchronization signal) is eliminated before output |
| | | CL1 signal | CSYNCI input (composite synchronization signal) horizontal synchronization signal part is separated before output |
| | | IHG signal | Internal synchronization signal is output |
| Composite mode | HSYNCI input | IHI signal (without 2fH modification) | HSYNCI input (composite synchronization signal) is output directly |
| | | IHI signal (with 2fH modification) | Double-frequency part of HSYNCI input (composite synchronization signal) is eliminated before output |
| | | CL1 signal | HSYNCI input (composite synchronization signal) horizontal synchronization signal part is separated before output |
| | | IHG signal | Internal synchronization signal is output |
| Separate mode | HSYNCI input | IHI signal (without 2fH modification) | HSYNCI input (horizontal synchronization signal) is output directly |
| | | IHI signal (with 2fH modification) | Meaningless unless there is a double-frequency part in the HSYNCI input (horizontal synchronization signal) |
| | | CL1 signal | HSYNCI input (horizontal synchronization signal) 1 interval is changed before output |
| | | IHG signal | Internal synchronization signal is output |

13.3.8 VSYNCO Output

With the VSYNCO output, the meaning of the signal source to be selected and use or non-use of modification varies according to the IVI signal source and the waveform required by external circuitry. The meaning of the VSYNCO output in each mode is shown in table 13.10.

Table 13.10 Meaning of VSYNCO Output in Each Mode

| Mode | IVI Signal | I VO Signal | Meaning of I VO Signal |
|-------------------------------|---------------|--|---|
| No signal | VFBACKI input | IVI signal (without fall modification or IHI synchronization) | VFBACKI input is output directly |
| | | IVI signal (without fall modification, with IHI synchronization) | Meaningless unless VFBACKI input is synchronized with HFBACKI input |
| | | IVI signal (with fall modification, without IHI synchronization) | VFBACKI input fall is modified before output |
| | | IVI signal (with fall modification and IHI synchronization) | VFBACKI input fall is modified and signal is synchronized with HFBACKI input before output |
| | | IVG signal | Internal synchronization signal is output |
| S-on-G mode or composite mode | PDC signal | IVI signal (without fall modification or IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated before output |
| | | IVI signal (without fall modification, with IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, and signal is synchronized with CSYNCI/HSYNCI input before output |
| | | IVI signal (with fall modification, without IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, and fall is modified before output |
| | | IVI signal (with fall modification and IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, fall is modified, and signal is synchronized with CSYNCI/HSYNCI input before output |
| | | IVG signal | Internal synchronization signal is output |

| Mode | IVI Signal | I VO Signal | Meaning of I VO Signal |
|---------------|--------------|--|--|
| Separate mode | VSYNCl input | IVI signal (without fall modification or IHI synchronization) | VSYNCl input (vertical synchronization signal) is output directly |
| | | IVI signal (without fall modification, with IHI synchronization) | Meaningless unless VSYNCl input (vertical synchronization signal) is synchronized with HSYNCl input (horizontal synchronization signal) |
| | | IVI signal (with fall modification, without IHI synchronization) | VSYNCl input (vertical synchronization signal) fall is modified before output |
| | | IVI signal (with fall modification and IHI synchronization) | VSYNCl input (vertical synchronization signal) fall is modified and signal is synchronized with HSYNCl input (horizontal synchronization signal) before output |
| | | IVG signal | Internal synchronization signal is output |

13.3.9 CBLANK Output

Using the signals generated/selected with timer connection, it is possible to generate a waveform based on the composite synchronization signal (blanking waveform).

One kind of blanking waveform is generated by combining HFBACKI and VFBACKI inputs, with the phase polarity made positive by means of bits HFINV and VFINV in TCONRI, with the IVO signal.

The composition logic is shown in figure 13.9.

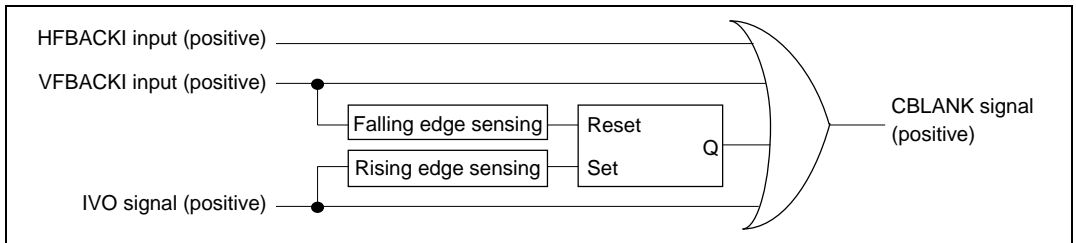


Figure 13.9 CBLANK Output Waveform Generation

Section 14 Watchdog Timer (WDT)

14.1 Overview

The H8S/2138 Group and H8S/2134 Group have an on-chip watchdog timer with two channels (WDT0, WDT1) for monitoring system operation. The WDT outputs an overflow signal if a system crash prevents the CPU from writing to the timer counter, allowing it to overflow. At the same time, the WDT can also generate an internal reset signal or internal NMI interrupt signal.

When this watchdog function is not needed, the WDT can be used as an interval timer. In interval timer mode, an interval timer interrupt is generated each time the counter overflows.

14.1.1 Features

WDT features are listed below.

- Switchable between watchdog timer mode and interval timer mode
 - WOVI interrupt generation in interval timer mode
- Internal reset or internal interrupt generated when the timer counter overflows
 - Choice of internal reset or NMI interrupt generation in watchdog timer mode
- Choice of 8 (WDT0) or 16 (WDT1) counter input clocks
 - Maximum WDT interval: system clock period \times 131072 \times 256
 - Subclock can be selected for the WDT1 input counter
 - Maximum interval when the subclock is selected: subclock period \times 256 \times 256

14.1.2 Block Diagram

Figures 14.1 (a) and (b) show block diagrams of WDT0 and WDT1.

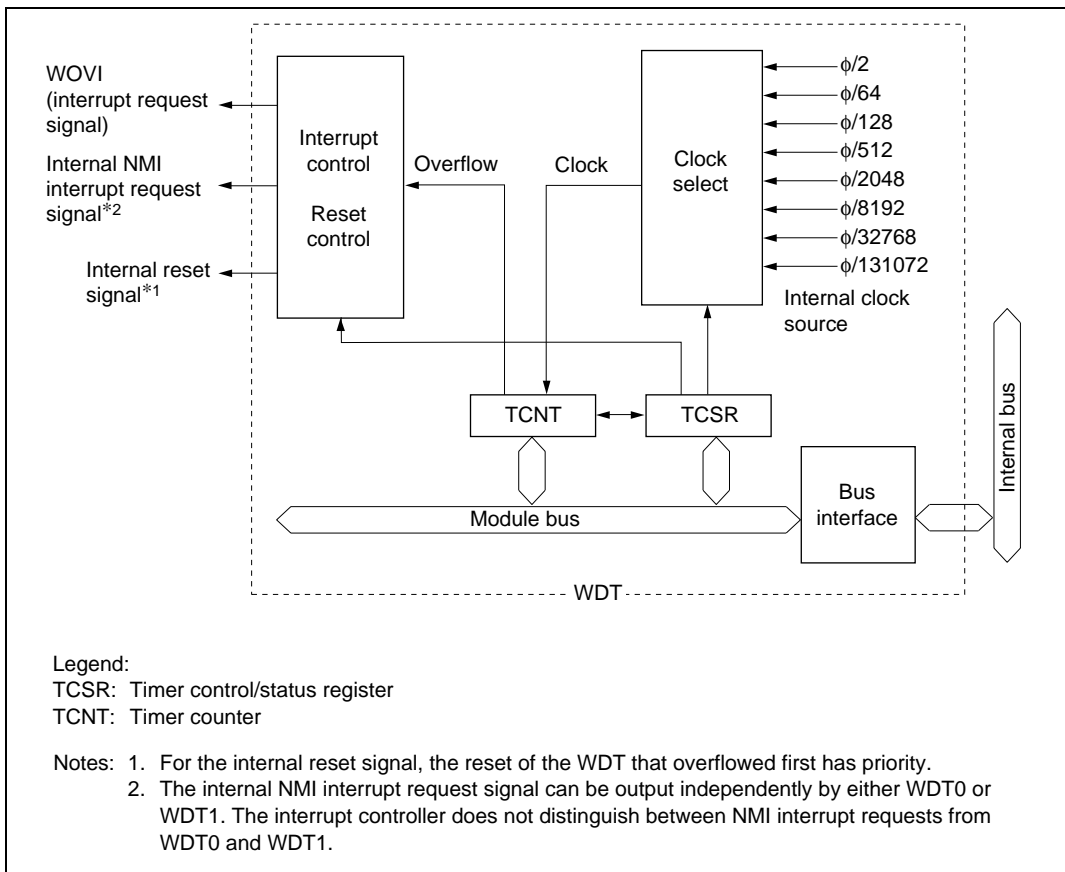


Figure 14.1 (a) Block Diagram of WDT0

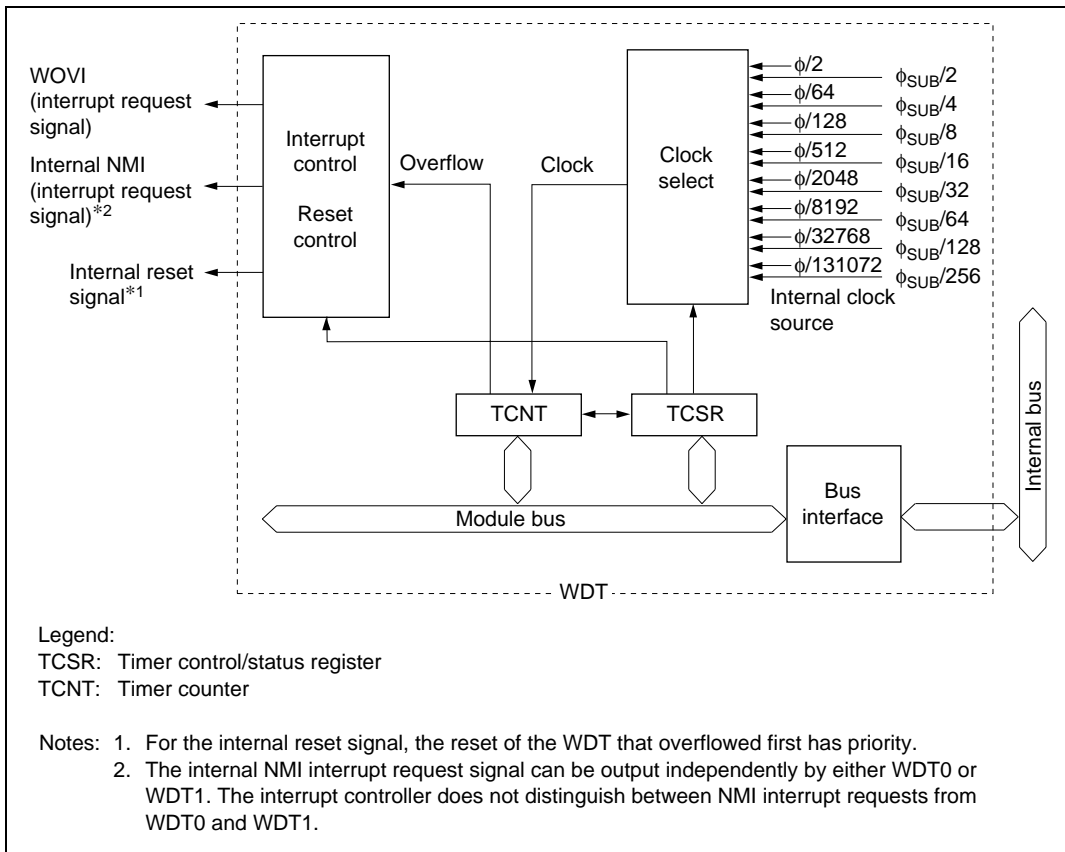


Figure 14.1 (b) Block Diagram of WDT1

14.1.3 Pin Configuration

Table 14.1 describes the WDT input pin.

Table 14.1 WDT Pin

| Name | Symbol | I/O | Function |
|-----------------------------|--------|-------|------------------------------------|
| External subclock input pin | EXCL | Input | WDT1 prescaler counter input clock |

14.1.4 Register Configuration

The WDT has four registers, as summarized in table 14.2. These registers control clock selection, WDT mode switching, the reset signal, etc.

Table 14.2 WDT Registers

| Channel | Name | Abbreviation | R/W | Initial Value | Address* ¹ | |
|---------|---------------------------------|--------------|---------------------|---------------|-----------------------|--------|
| | | | | | Write* ² | Read |
| 0 | Timer control/status register 0 | TCSR0 | R/(W)* ³ | H'00 | H'FFA8 | H'FFA8 |
| | Timer counter 0 | TCNT0 | R/W | H'00 | H'FFA8 | H'FFA9 |
| 1 | Timer control/status register 1 | TCSR1 | R/(W)* ³ | H'00 | H'FFEA | H'FFEA |
| | Timer counter 1 | TCNT1 | R/W | H'00 | H'FFEA | H'FFEB |
| Common | System control register | SYSCR | R/W | H'09 | H'FFC4 | H'FFC4 |

Notes: 1. Lower 16 bits of the address.

2. For details of write operations, see section 14.2.4, Notes on Register Access.

3. Only 0 can be written in bit 7, to clear the flag.

14.2 Register Descriptions

14.2.1 Timer Counter (TCNT)

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

TCNT is an 8-bit readable/writable* up-counter.

When the TME bit is set to 1 in TCSR, TCNT starts counting pulses generated from the internal clock source selected by bits CKS2 to CKS0 in TCSR. When the TCNT value overflows (changes from H'FF to H'00), the OVF flag in TCSR is set to 1, and an internal reset, NMI interrupt, interval timer interrupt (WOVI), etc., can be generated, according to the mode selected by the $\overline{WT}/\overline{IT}$ bit and RST/ \overline{NMI} bit.

TCNT is initialized to H'00 by a reset, in hardware standby mode, or when the TME bit is cleared to 0. It is not initialized in software standby mode.

Note: * TCNT is write-protected by a password to prevent accidental overwriting. For details see section 14.2.4, Notes on Register Access.

14.2.2 Timer Control/Status Register (TCSR)

- TCSR0

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|---------------------|-----|------|-----------------------|------|------|------|
| | OVF | WT/ \overline{IT} | TME | RSTS | RST/ \overline{NMI} | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Only 0 can be written, to clear the flag.

- TCSR1

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|---------------------|-----|-----|-----------------------|------|------|------|
| | OVF | WT/ \overline{IT} | TME | PSS | RST/ \overline{NMI} | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Only 0 can be written, to clear the flag.

TCSR is an 8-bit readable/writable* register. Its functions include selecting the clock source to be input to TCNT, and the timer mode.

TCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Note: * TCSR is write-protected by a password to prevent accidental overwriting. For details see section 14.2.4, Notes on Register Access.

Bit 7—Overflow Flag (OVF): A status flag that indicates that TCNT has overflowed from H'FF to H'00.

Bit 7

| OVF | Description |
|-----|--|
| 0 | [Clearing conditions] (Initial value) <ul style="list-style-type: none"> • Write 0 in the TME bit • Read TCSR when OVF = 1*, then write 0 in OVFA |
| 1 | [Setting condition] When TCNT overflows (changes from H'FF to H'00) (When internal reset request generation is selected in watchdog timer mode, OVF is cleared automatically by the internal reset.) |

Note: * When OVF flag is polled and the interval timer interrupt is disabled, OVF=1 must be read at least twice.

Bit 6—Timer Mode Select (WT/IT): Selects whether the WDT is used as a watchdog timer or interval timer. If used as an interval timer, the WDT generates an interval timer interrupt request (WOVI) when TCNT overflows. If used as a watchdog timer, the WDT generates a reset or NMI interrupt when TCNT overflows.

Bit 6

| WT/IT | Description |
|-------|--|
| 0 | Interval timer: Sends the CPU an interval timer interrupt request (WOVI) when TCNT overflows (Initial value) |
| 1 | Watchdog timer: Generates a reset or NMI interrupt when TCNT overflows |

Bit 5—Timer Enable (TME): Selects whether TCNT runs or is halted.

Bit 5

| TME | Description |
|-----|--|
| 0 | TCNT is initialized to H'00 and halted (Initial value) |
| 1 | TCNT counts |

TCSR0 Bit 4—Reset Select (RSTS): Reserved. This bit should not be set to 1.

TCSR1 Bit 4—Prescaler Select (PSS): Selects the input clock source for TCNT in WDT1. For details, see the description of the CKS2 to CKS0 bits below.

TCSR1**Bit 4**

| PSS | Description |
|-----|--|
| 0 | TCNT counts ϕ -based prescaler (PSM) divided clock pulses (Initial value) |
| 1 | TCNT counts ϕ SUB-based prescaler (PSS) divided clock pulses |

Bit 3—Reset or NMI ($\overline{\text{RST/NMI}}$): Specifies whether an internal reset or NMI interrupt is requested on TCNT overflow in watchdog timer mode.

Bit 3

| RST/NMI | Description |
|---------|---|
| 0 | An NMI interrupt is requested (Initial value) |
| 1 | An internal reset is requested |

Bits 2 to 0—Clock Select 2 to 0 (CKS2 to CKS0): These bits select an internal clock source, obtained by dividing the system clock (ϕ), or subclock (ϕ SUB) for input to TCNT.

- WDT0 input clock selection

| Bit 2 | Bit 1 | Bit 0 | Description | |
|-------|-------|-------|--------------------------|---|
| CKS2 | CKS1 | CKS0 | Clock | Overflow Period* (when $\phi = 20$ MHz) |
| 0 | 0 | 0 | $\phi/2$ (Initial value) | 25.6 μ s |
| | | 1 | $\phi/64$ | 819.2 μ s |
| | 1 | 0 | $\phi/128$ | 1.6 ms |
| | | 1 | $\phi/512$ | 6.6 ms |
| 1 | 0 | 0 | $\phi/2048$ | 26.2 ms |
| | | 1 | $\phi/8192$ | 104.9 ms |
| | 1 | 0 | $\phi/32768$ | 419.4 ms |
| | | 1 | $\phi/131072$ | 1.68 s |

Note: * The overflow period is the time from when TCNT starts counting up from H'00 until overflow occurs.

- WDT1 input clock selection

| Bit 4 | Bit 2 | Bit 1 | Bit 0 | Description | |
|-------|-------|-------|-------|--------------------------|---|
| PSS | CKS2 | CKS1 | CKS0 | Clock | Overflow Period* (when $\phi = 20$ MHz and $\phi_{SUB} = 32.768$ kHz) |
| 0 | 0 | 0 | 0 | $\phi/2$ (Initial value) | 25.6 μ s |
| | | | 1 | $\phi/64$ | 819.2 μ s |
| | | 1 | 0 | $\phi/128$ | 1.6 ms |
| | | | 1 | $\phi/512$ | 6.6 ms |
| | 1 | 0 | 0 | $\phi/2048$ | 26.2 ms |
| | | | 1 | $\phi/8192$ | 104.9 ms |
| | | 1 | 0 | $\phi/32768$ | 419.4 ms |
| | | | 1 | $\phi/131072$ | 1.68 s |
| 1 | 0 | 0 | 0 | $\phi_{SUB}/2$ | 15.6 ms |
| | | | 1 | $\phi_{SUB}/4$ | 31.3 ms |
| | | 1 | 0 | $\phi_{SUB}/8$ | 62.5 ms |
| | | | 1 | $\phi_{SUB}/16$ | 125 ms |
| | 1 | 0 | 0 | $\phi_{SUB}/32$ | 250 ms |
| | | | 1 | $\phi_{SUB}/64$ | 500 ms |
| | | 1 | 0 | $\phi_{SUB}/128$ | 1 s |
| | | | 1 | $\phi_{SUB}/256$ | 2 s |

Note: * The overflow period is the time from when TCNT starts counting up from H'00 until overflow occurs.

14.2.3 System Control Register (SYSCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|------|-------|-----|------|
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

Only bit 3 is described here. For details on functions not related to the watchdog timer, see sections 3.2.2 and 5.2.1, System Control Register (SYSCR), and the descriptions of the relevant modules.

Bit 3—External Reset (XRST): Indicates the reset source. When the watchdog timer is used, a reset can be generated by watchdog timer overflow in addition to external reset input. XRST is a read-only bit. It is set to 1 by an external reset, and when the RST/NMI bit is 1, is cleared to 0 by an internal reset due to watchdog timer overflow.

Bit 3

| XRST | Description |
|------|--|
| 0 | Reset is generated by watchdog timer overflow |
| 1 | Reset is generated by external reset input (Initial value) |

14.2.4 Notes on Register Access

The watchdog timer's TCNT and TCSR registers differ from other registers in being more difficult to write to. The procedures for writing to and reading these registers are given below.

Writing to TCNT and TCSR (Example of WDT0): These registers must be written to by a word transfer instruction. They cannot be written to with byte transfer instructions.

Figure 14.2 shows the format of data written to TCNT and TCSR. TCNT and TCSR both have the same write address. For a write to TCNT, the upper byte of the written word must contain H'5A and the lower byte must contain the write data. For a write to TCSR, the upper byte of the written word must contain H'A5 and the lower byte must contain the write data. This transfers the write data from the lower byte to TCNT or TCSR.

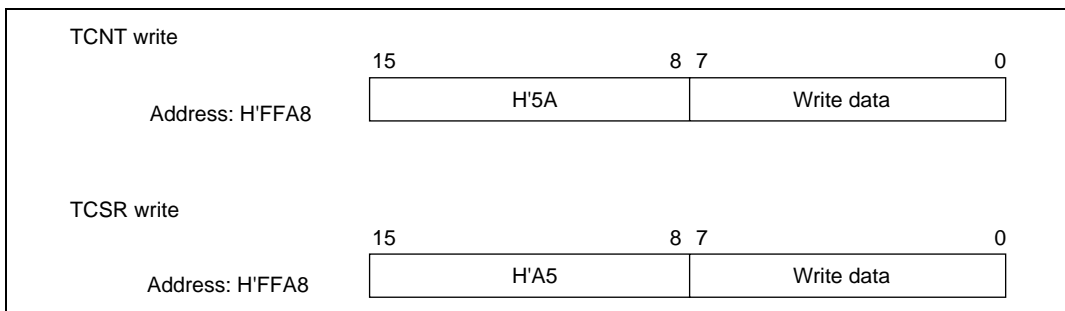


Figure 14.2 Format of Data Written to TCNT and TCSR (Example of WDT0)

Reading TCNT and TCSR (Example of WDT0): These registers are read in the same way as other registers. The read addresses are H'FFA8 for TCSR, and H'FFA9 for TCNT.

14.3 Operation

14.3.1 Watchdog Timer Operation

To use the WDT as a watchdog timer, set the $\overline{WT/IT}$ and TME bits in TCSR to 1. Software must prevent TCNT overflows by rewriting the TCNT value (normally by writing H'00) before overflow occurs. This ensures that TCNT does not overflow while the system is operating normally. If TCNT overflows without being rewritten because of a system crash or other error, an internal reset or NMI interrupt request is generated.

When the $\overline{RST/NMI}$ bit is set to 1, the chip is reset for 518 system clock periods (518ϕ) by a counter overflow. This is illustrated in figure 14.3.

When the $\overline{RST/NMI}$ bit cleared to 0, an NMI interrupt request is generated by a counter overflow.

An internal reset request from the watchdog timer and reset input from the \overline{RES} pin are handled via the same vector. The reset source can be identified from the value of the XRST bit in SYSCR.

If a reset caused by an input signal from the \overline{RES} pin and a reset caused by WDT overflow occur simultaneously, the \overline{RES} pin reset has priority, and the XRST bit in SYSCR is set to 1.

An NMI interrupt request from the watchdog timer and an interrupt request from the NMI pin are handled via the same vector. Simultaneous handling of a watchdog timer NMI interrupt request and an NMI pin interrupt request must therefore be avoided.

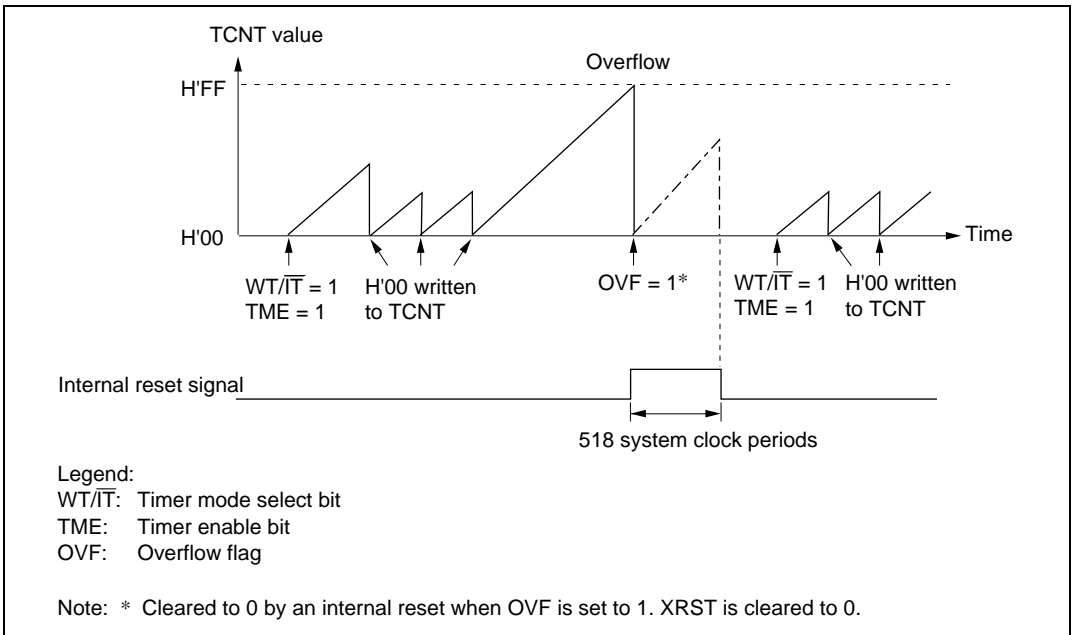


Figure 14.3 Operation in Watchdog Timer Mode

14.3.2 Interval Timer Operation

To use the WDT as an interval timer, clear the $\overline{\text{WT/IT}}$ bit in TCSR to 0 and set the TME bit to 1. An interval timer interrupt (WOVI) is generated each time TCNT overflows, provided that the WDT is operating as an interval timer, as shown in figure 14.4. This function can be used to generate interrupt requests at regular intervals.

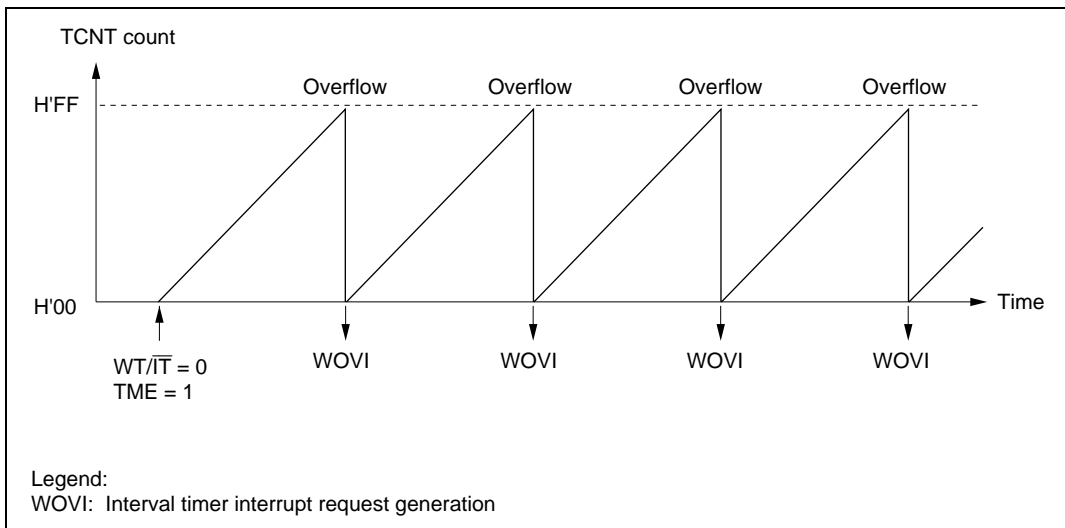


Figure 14.4 Operation in Interval Timer Mode

14.3.3 Timing of Setting of Overflow Flag (OVF)

The OVF flag is set to 1 if TCNT overflows during interval timer operation. At the same time, an interval timer interrupt (WOVI) is requested. This timing is shown in figure 14.5.

If NMI request generation is selected in watchdog timer mode, when TCNT overflows the OVF bit in TCSR is set to 1 and at the same time an NMI interrupt is requested.

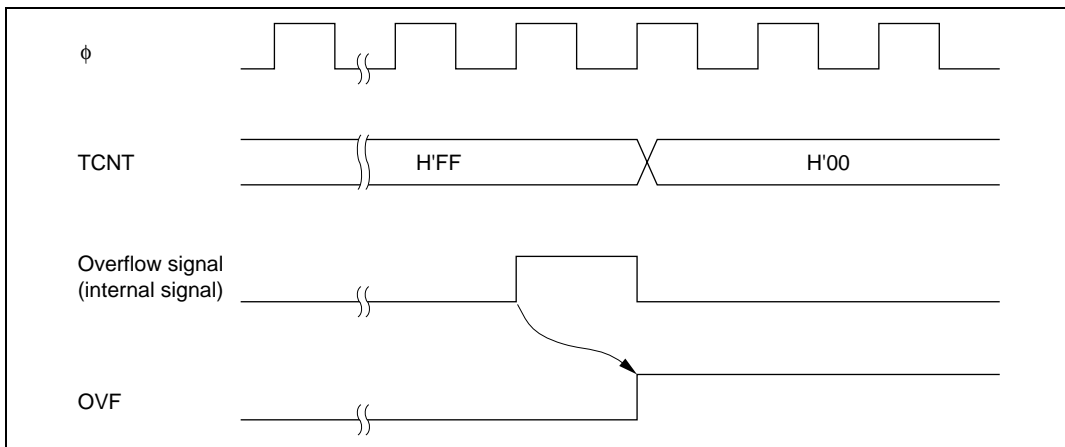


Figure 14.5 Timing of OVF Setting

14.4 Interrupts

During interval timer mode operation, an overflow generates an interval timer interrupt (WOVI). The interval timer interrupt is requested whenever the OVF flag is set to 1 in TCSR. OVF must be cleared to 0 in the interrupt handling routine. When NMI interrupt request generation is selected in watchdog timer mode, an overflow generates an NMI interrupt request.

14.5 Usage Notes

14.5.1 Contention between Timer Counter (TCNT) Write and Increment

If a timer counter clock pulse is generated during the T_2 state of a TCNT write cycle, the write takes priority and the timer counter is not incremented. Figure 14.6 shows this operation.

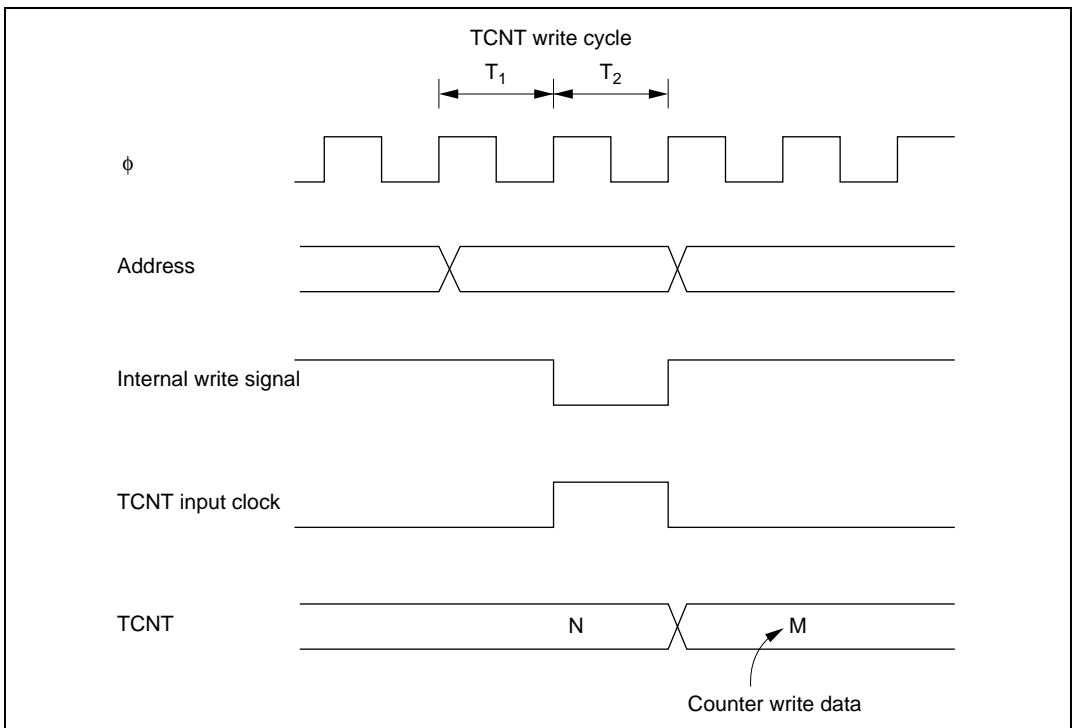


Figure 14.6 Contention between TCNT Write and Increment

14.5.2 Changing Value of CKS2 to CKS0

If bits CKS2 to CKS0 in TCSR are written to while the WDT is operating, errors could occur in the incrementation. Software must stop the watchdog timer (by clearing the TME bit to 0) before changing the value of bits CKS2 to CKS0.

14.5.3 Switching between Watchdog Timer Mode and Interval Timer Mode

If the mode is switched from watchdog timer to interval timer, or vice versa, while the WDT is operating, errors could occur in the incrementation. Software must stop the watchdog timer (by clearing the TME bit to 0) before switching the mode.

14.5.4 Counter Value in Transitions between High-Speed Mode, Subactive Mode, and Watch Mode

If the mode is switched between high-speed mode and subactive mode or between high-speed mode and watch mode when WDT1 is used as a realtime clock counter, an error will occur in the counter value when the internal clock is switched.

When the mode is switched from high-speed mode to subactive mode or watch mode, the increment timing is delayed by approximately 2 or 3 clock cycles when the WDT1 control clock is switched from the main clock to the subclock.

Also, since the main clock oscillator is halted during subclock operation, when the mode is switched from watch mode or subactive mode to high-speed mode, the clock is not supplied until internal oscillation stabilizes. As a result, after oscillation is started, counter incrementing is halted during the oscillation stabilization time set by bits STS2 to STS0 in SBYCR, and there is a corresponding discrepancy in the counter value.

Caution is therefore required when using WDT1 as the realtime clock counter.

No error occurs in the counter value while WDT1 is operating in the same mode.

14.5.5 OVF Flag Clear Condition

To clear OVF flag in WOVI handling routine, read TCSR when OVF=1, then write with 0 to OVF, as stated above. When WOVI is masked and OVF flag is poling, if contention between OVF flag set and TCSR read is occurred, OVF=1 is read but OVF can not be cleared by writing with 0 to OVF.

In this case, reading TCSR when OVF=1 two times meet the requirements of OVF clear condition. Please read TCSR when OVF=1 two times before writing with 0 to OVF.

```
LOOP    BTST.B    #7,@TCSR    ; OVF flag read
        BEQ      LOOP        ; if OVF=1, exit from loop
        MOV.B    @TCSR,R0L    ; OVF=1 read again
        MOV.W    #H'A521,R0   ; OVF flag clear
        MOV.W    R0,@TCSR    ; :
```

Section 15 Serial Communication Interface (SCI, IrDA)

15.1 Overview

The H8S/2138 Group and H8S/2134 Group are equipped with a 3-channel serial communication interface (SCI). The SCI can handle both asynchronous and clocked synchronous serial communication. A function is also provided for serial communication between processors (multiprocessor communication function).

One of the three SCI channels can transmit and receive IrDA communication waveforms based on IrDA specification version 1.0.

15.1.1 Features

SCI features are listed below.

- Choice of asynchronous or synchronous serial communication mode
 - Asynchronous mode
 - Serial data communication is executed using an asynchronous system in which synchronization is achieved character by character
 - Serial data communication can be carried out with standard asynchronous communication chips such as a Universal Asynchronous Receiver/Transmitter (UART) or Asynchronous Communication Interface Adapter (ACIA)
 - A multiprocessor communication function is provided that enables serial data communication with a number of processors
 - Choice of 12 serial data transfer formats
 - Data length: 7 or 8 bits
 - Stop bit length: 1 or 2 bits
 - Parity: Even, odd, or none
 - Multiprocessor bit: 1 or 0
 - Receive error detection: Parity, overrun, and framing errors
 - Break detection: Break can be detected by reading the RxD pin level directly in case of a framing error
 - Synchronous mode
 - Serial data communication is synchronized with a clock
 - Serial data communication can be carried out with other chips that have a synchronous communication function

- One serial data transfer format
 - Data length: 8 bits
- Receive error detection: Overrun errors detected
- Full-duplex communication capability
 - The transmitter and receiver are mutually independent, enabling transmission and reception to be executed simultaneously
 - Double-buffering is used in both the transmitter and the receiver, enabling continuous transmission and continuous reception of serial data
- LSB-first or MSB-first transfer can be selected
 - This selection can be made regardless of the communication mode (with the exception of 7-bit data transfer in asynchronous mode)*

Note: * LSB-first transfer is used in the examples in this section.

- On-chip baud rate generator allows any bit rate to be selected
- Choice of serial clock source: internal clock from baud rate generator or external clock from SCK pin
- Capability of transmit and receive clock output
 - The P86/SCK1 and P42/SCK2 pins are CMOS type outputs
 - The P52/SCK0 pin is an NMOS push-pull type output in the H8S/2138 Group and a CMOS output in the H8S/2134 Group (When the P52/SCK0 pin is used as an output in the H8S/2138 Group, external pull-up resistor must be connected in order to output high level)
- Four interrupt sources
 - Four interrupt sources (transmit-data-empty, transmit-end, receive-data-full, and receive error) that can issue requests independently
 - The transmit-data-empty interrupt and receive-data-full interrupt can activate the data transfer controller (DTC) to execute data transfer

15.1.2 Block Diagram

Figure 15.1 shows a block diagram of the SCI.

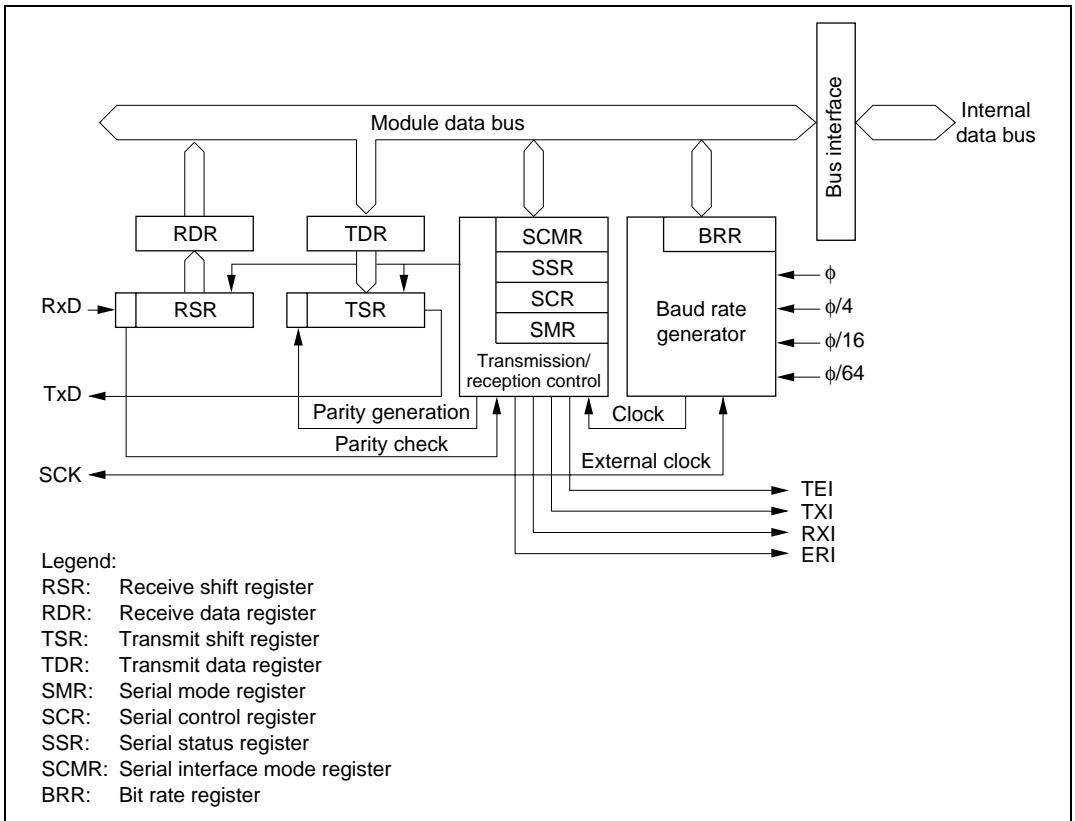


Figure 15.1 Block Diagram of SCI

15.1.3 Pin Configuration

Table 15.1 shows the serial pins used by the SCI.

Table 15.1 SCI Pins

| Channel | Pin Name | Symbol* | I/O | Function |
|---------|---------------------|------------|--------|--|
| 0 | Serial clock pin 0 | SCK0 | I/O | SCI0 clock input/output |
| | Receive data pin 0 | RxD0 | Input | SCI0 receive data input |
| | Transmit data pin 0 | TxD0 | Output | SCI0 transmit data output |
| 1 | Serial clock pin 1 | SCK1 | I/O | SCI1 clock input/output |
| | Receive data pin 1 | RxD1 | Input | SCI1 receive data input |
| | Transmit data pin 1 | TxD1 | Output | SCI1 transmit data output |
| 2 | Serial clock pin 2 | SCK2 | I/O | SCI2 clock input/output |
| | Receive data pin 2 | RxD2/IrRxD | Input | SCI2 receive data input (normal/IrDA) |
| | Transmit data pin 2 | TxD2/IrTxD | Output | SCI2 transmit data output (normal/IrDA) |

Note: * The abbreviations SCK, RxD, and TxD are used in the text, omitting the channel number.

15.1.4 Register Configuration

The SCI has the internal registers shown in table 15.2. These registers are used to specify asynchronous mode or synchronous mode, the data format, and the bit rate, and to control the transmitter/receiver.

Table 15.2 SCI Registers

| Channel | Name | Abbreviation | R/W | Initial Value | Address*1 |
|---------|--------------------------------------|--------------|---------|---------------|-----------|
| 0 | Serial mode register 0 | SMR0 | R/W | H'00 | H'FFD8*3 |
| | Bit rate register 0 | BRR0 | R/W | H'FF | H'FFD9*3 |
| | Serial control register 0 | SCR0 | R/W | H'00 | H'FFDA |
| | Transmit data register 0 | TDR0 | R/W | H'FF | H'FFDB |
| | Serial status register 0 | SSR0 | R/(W)*2 | H'84 | H'FFDC |
| | Receive data register 0 | RDR0 | R | H'00 | H'FFDD |
| | Serial interface mode register 0 | SCMR0 | R/W | H'F2 | H'FFDE*3 |
| 1 | Serial mode register 1 | SMR1 | R/W | H'00 | H'FF88*3 |
| | Bit rate register 1 | BRR1 | R/W | H'FF | H'FF89*3 |
| | Serial control register 1 | SCR1 | R/W | H'00 | H'FF8A |
| | Transmit data register 1 | TDR1 | R/W | H'FF | H'FF8B |
| | Serial status register 1 | SSR1 | R/(W)*2 | H'84 | H'FF8C |
| | Receive data register 1 | RDR1 | R | H'00 | H'FF8D |
| | Serial interface mode register 1 | SCMR1 | R/W | H'F2 | H'FF8E*3 |
| 2 | Serial mode register 2 | SMR2 | R/W | H'00 | H'FFA0*3 |
| | Bit rate register 2 | BRR2 | R/W | H'FF | H'FFA1*3 |
| | Serial control register 2 | SCR2 | R/W | H'00 | H'FFA2 |
| | Transmit data register 2 | TDR2 | R/W | H'FF | H'FFA3 |
| | Serial status register 2 | SSR2 | R/(W)*2 | H'84 | H'FFA4 |
| | Receive data register 2 | RDR2 | R | H'00 | H'FFA5 |
| | Serial interface mode register 2 | SCMR2 | R/W | H'F2 | H'FFA6*3 |
| | Keyboard comparator control register | KBCOMP | R/W | H'00 | H'FEE4 |
| Common | Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | | MSTPCRL | R/W | H'FF | H'FF87 |

Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written, to clear flags.

3. Some serial communication interface registers are assigned to the same addresses as other registers. In this case, register selection is performed by the IICE bit in the serial timer control register (STCR).

15.2 Register Descriptions

15.2.1 Receive Shift Register (RSR)

| | | | | | | | | |
|------------|---|---|---|---|---|---|---|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Read/Write | — | — | — | — | — | — | — | — |

RSR is a register used to receive serial data.

The SCI sets serial data input from the RxD pin in RSR in the order received, starting with the LSB (bit 0), and converts it to parallel data. When one byte of data has been received, it is transferred to RDR automatically.

RSR cannot be directly read or written to by the CPU.

15.2.2 Receive Data Register (RDR)

| | | | | | | | | |
|---------------|---|---|---|---|---|---|---|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

RDR is a register that stores received serial data.

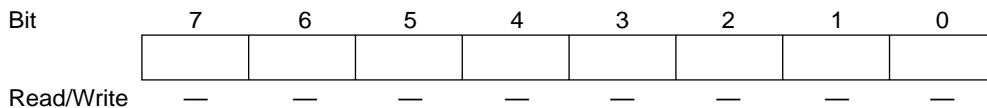
When the SCI has received one byte of serial data, it transfers the received serial data from RSR to RDR where it is stored, and completes the receive operation. After this, RSR is receive-enabled.

Since RSR and RDR function as a double buffer in this way, continuous receive operations can be performed.

RDR is a read-only register, and cannot be written to by the CPU.

RDR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

15.2.3 Transmit Shift Register (TSR)



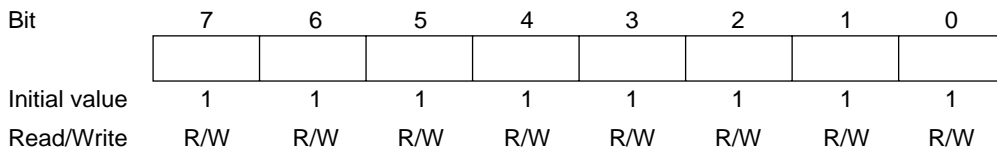
TSR is a register used to transmit serial data.

To perform serial data transmission, the SCI first transfers transmit data from TDR to TSR, then sends the data to the TxD pin starting with the LSB (bit 0).

When transmission of one byte is completed, the next transmit data is transferred from TDR to TSR, and transmission started, automatically. However, data transfer from TDR to TSR is not performed if the TDRE bit in SSR is set to 1.

TSR cannot be directly read or written to by the CPU.

15.2.4 Transmit Data Register (TDR)



TDR is an 8-bit register that stores data for serial transmission.

When the SCI detects that TSR is empty, it transfers the transmit data written in TDR to TSR and starts serial transmission. Continuous serial transmission can be carried out by writing the next transmit data to TDR during serial transmission of the data in TSR.

TDR can be read or written to by the CPU at all times.

TDR is initialized to H'FF by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

15.2.5 Serial Mode Register (SMR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------------|-----|-----|--------------|------|-----|------|------|
| | C/ \bar{A} | CHR | PE | O/ \bar{E} | STOP | MP | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

SMR is an 8-bit register used to set the SCI's serial transfer format and select the baud rate generator clock source.

SMR can be read or written to by the CPU at all times.

SMR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Communication Mode (C/ \bar{A}): Selects asynchronous mode or synchronous mode as the SCI operating mode.

Bit 7

| C/ \bar{A} | Description |
|--------------|-----------------------------------|
| 0 | Asynchronous mode (Initial value) |
| 1 | Synchronous mode |

Bit 6—Character Length (CHR): Selects 7 or 8 bits as the data length in asynchronous mode. In synchronous mode, a fixed data length of 8 bits is used regardless of the CHR setting.

Bit 6

| CHR | Description |
|-----|----------------------------|
| 0 | 8-bit data (Initial value) |
| 1 | 7-bit data* |

Note: * When 7-bit data is selected, the MSB (bit 7) of TDR is not transmitted, and LSB-first/MSB-first selection is not available.

Bit 5—Parity Enable (PE): In asynchronous mode, selects whether or not parity bit addition is performed in transmission, and parity bit checking in reception. In synchronous mode, or when a multiprocessor format is used, parity bit addition and checking is not performed, regardless of the PE bit setting.

Bit 5

| PE | Description |
|----|---|
| 0 | Parity bit addition and checking disabled (Initial value) |
| 1 | Parity bit addition and checking enabled* |

Note: * When the PE bit is set to 1, the parity (even or odd) specified by the O/E bit is added to transmit data before transmission. In reception, the parity bit is checked for the parity (even or odd) specified by the O/E bit.

Bit 4—Parity Mode (O/E): Selects either even or odd parity for use in parity addition and checking.

The O/E bit setting is only valid when the PE bit is set to 1, enabling parity bit addition and checking, in asynchronous mode. The O/E bit setting is invalid in synchronous mode, when parity bit addition and checking is disabled in asynchronous mode, and when a multiprocessor format is used.

Bit 4

| O/E | Description |
|-----|---|
| 0 | Even parity* ¹ (Initial value) |
| 1 | Odd parity* ² |

Notes: 1. When even parity is set, parity bit addition is performed in transmission so that the total number of 1 bits in the transmit character plus the parity bit is even.
In reception, a check is performed to see if the total number of 1 bits in the receive character plus the parity bit is even.

2. When odd parity is set, parity bit addition is performed in transmission so that the total number of 1 bits in the transmit character plus the parity bit is odd.
In reception, a check is performed to see if the total number of 1 bits in the receive character plus the parity bit is odd.

Bit 3—Stop Bit Length (STOP): Selects 1 or 2 bits as the stop bit length in asynchronous mode. The STOP bit setting is only valid in asynchronous mode. If synchronous mode is set the STOP bit setting is invalid since stop bits are not added.

Bit 3

| STOP | Description |
|------|--|
| 0 | 1 stop bit* ¹ (Initial value) |
| 1 | 2 stop bits* ² |

Notes: 1. In transmission, a single 1 bit (stop bit) is added to the end of a transmit character before it is sent.
 2. In transmission, two 1 bits (stop bits) are added to the end of a transmit character before it is sent.

In reception, only the first stop bit is checked, regardless of the STOP bit setting. If the second stop bit is 1, it is treated as a stop bit; if it is 0, it is treated as the start bit of the next transmit character.

Bit 2—Multiprocessor Mode (MP): Selects multiprocessor format. When multiprocessor format is selected, the PE bit and O/ \bar{E} bit parity settings are invalid. The MP bit setting is only valid in asynchronous mode; it is invalid in synchronous mode.

For details of the multiprocessor communication function, see section 15.3.3, Multiprocessor Communication Function.

Bit 2

| MP | Description |
|----|--|
| 0 | Multiprocessor function disabled (Initial value) |
| 1 | Multiprocessor format selected |

Bits 1 and 0—Clock Select 1 and 0 (CKS1, CKS0): These bits select the clock source for the baud rate generator. The clock source can be selected from ϕ , $\phi/4$, $\phi/16$, and $\phi/64$, according to the setting of bits CKS1 and CKS0.

For the relation between the clock source, the bit rate register setting, and the baud rate, see section 15.2.8, Bit Rate Register.

| Bit 1 | Bit 0 | Description | |
|-------|-------|-----------------|-----------------|
| CKS1 | CKS0 | | |
| 0 | 0 | ϕ clock | (Initial value) |
| | 1 | $\phi/4$ clock | |
| 1 | 0 | $\phi/16$ clock | |
| | 1 | $\phi/64$ clock | |

15.2.6 Serial Control Register (SCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|------|------|------|------|
| | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

SCR is a register that performs enabling or disabling of SCI transfer operations, serial clock output in asynchronous mode, and interrupt requests, and selection of the serial clock source.

SCR can be read or written to by the CPU at all times.

SCR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Transmit Interrupt Enable (TIE): Enables or disables transmit-data-empty interrupt (TXI) request generation when serial transmit data is transferred from TDR to TSR and the TDRE flag in SSR is set to 1.

Bit 7

| TIE | Description |
|-----|---|
| 0 | Transmit-data-empty interrupt (TXI) request disabled* (Initial value) |
| 1 | Transmit-data-empty interrupt (TXI) request enabled |

Note: * TXI interrupt request cancellation can be performed by reading 1 from the TDRE flag, then clearing it to 0, or clearing the TIE bit to 0.

Bit 6—Receive Interrupt Enable (RIE): Enables or disables receive-data-full interrupt (RXI) request and receive-error interrupt (ERI) request generation when serial receive data is transferred from RSR to RDR and the RDRF flag in SSR is set to 1.

Bit 6

| RIE | Description |
|-----|---|
| 0 | Receive-data-full interrupt (RXI) request and receive-error interrupt (ERI) request disabled* (Initial value) |
| 1 | Receive-data-full interrupt (RXI) request and receive-error interrupt (ERI) request enabled |

Note: * RXI and ERI interrupt request cancellation can be performed by reading 1 from the RDRF, FER, PER, or ORER flag, then clearing the flag to 0, or clearing the RIE bit to 0.

Bit 5—Transmit Enable (TE): Enables or disables the start of serial transmission by the SCI.

Bit 5

| TE | Description |
|----|---|
| 0 | Transmission disabled* ¹ (Initial value) |
| 1 | Transmission enabled* ² |

Notes: 1. The TDRE flag in SSR is fixed at 1.

2. In this state, serial transmission is started when transmit data is written to TDR and the TDRE flag in SSR is cleared to 0.

SMR setting must be performed to decide the transmission format before setting the TE bit to 1.

Bit 4—Receive Enable (RE): Enables or disables the start of serial reception by the SCI.

Bit 4

| RE | Description |
|----|--|
| 0 | Reception disabled* ¹ (Initial value) |
| 1 | Reception enabled* ² |

Notes: 1. Clearing the RE bit to 0 does not affect the RDRF, FER, PER, and ORER flags, which retain their states.

2. Serial reception is started in this state when a start bit is detected in asynchronous mode or serial clock input is detected in synchronous mode.
SMR setting must be performed to decide the reception format before setting the RE bit to 1.

Bit 3—Multiprocessor Interrupt Enable (MPIE): Enables or disables multiprocessor interrupts. The MPIE bit setting is only valid in asynchronous mode when receiving with the MP bit in SMR set to 1.

The MPIE bit setting is invalid in synchronous mode or when the MP bit is cleared to 0.

Bit 3

| MPIE | Description |
|------|---|
| 0 | Multiprocessor interrupts disabled (normal reception performed) (Initial value) [Clearing conditions] <ul style="list-style-type: none"> • When the MPIE bit is cleared to 0 • When data with MPB = 1 is received |
| 1 | Multiprocessor interrupts enabled* Receive interrupt (RXI) requests, receive-error interrupt (ERI) requests, and setting of the RDRF, FER, and ORER flags in SSR are disabled until data with the multiprocessor bit set to 1 is received. |

Note: * When receive data including MPB = 0 is received, receive data transfer from RSR to RDR, receive error detection, and setting of the RDRF, FER, and ORER flags in SSR, is not performed. When receive data with MPB = 1 is received, the MPB bit in SSR is set to 1, the MPIE bit is cleared to 0 automatically, and generation of RXI and ERI interrupts (when the TIE and RIE bits in SCR are set to 1) and FER and ORER flag setting is enabled.

Bit 2—Transmit End Interrupt Enable (TEIE): Enables or disables transmit-end interrupt (TEI) request generation if there is no valid transmit data in TDR when the MSB is transmitted.

Bit 2

| TEIE | Description |
|------|--|
| 0 | Transmit-end interrupt (TEI) request disabled* (Initial value) |
| 1 | Transmit-end interrupt (TEI) request enabled* |

Note: * TEI cancellation can be performed by reading 1 from the TDRE flag in SSR, then clearing it to 0 and clearing the TEND flag to 0, or clearing the TEIE bit to 0.

Bits 1 and 0—Clock Enable 1 and 0 (CKE1, CKE0): These bits are used to select the SCI clock source and enable or disable clock output from the SCK pin. The combination of the CKE1 and CKE0 bits determines whether the SCK pin functions as an I/O port, the serial clock output pin, or the serial clock input pin.

The setting of the CKE0 bit, however, is only valid for internal clock operation (CKE1 = 0) in asynchronous mode. The CKE0 bit setting is invalid in synchronous mode, and in the case of external clock operation (CKE1 = 1). The setting of bits CKE1 and CKE0 must be carried out before the SCI's operating mode is determined using SMR.

For details of clock source selection, see table 15.9 in section 15.3, Operation.

| Bit 1 | Bit 0 | Description | |
|-------|-------|-------------------|---|
| CKE1 | CKE0 | Description | |
| 0 | 0 | Asynchronous mode | Internal clock/SCK pin functions as I/O port* ¹ |
| | | Synchronous mode | Internal clock/SCK pin functions as serial clock output* ¹ |
| | 1 | Asynchronous mode | Internal clock/SCK pin functions as clock output* ² |
| | | Synchronous mode | Internal clock/SCK pin functions as serial clock output |
| 1 | 0 | Asynchronous mode | External clock/SCK pin functions as clock input* ³ |
| | | Synchronous mode | External clock/SCK pin functions as serial clock input |
| | 1 | Asynchronous mode | External clock/SCK pin functions as clock input* ³ |
| | | Synchronous mode | External clock/SCK pin functions as serial clock input |

- Notes: 1. Initial value
 2. Outputs a clock of the same frequency as the bit rate.
 3. Inputs a clock with a frequency 16 times the bit rate.

15.2.7 Serial Status Register (SSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|------|-----|------|
| | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT |
| Initial value | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R | R | R/W |

Note: * Only 0 can be written, to clear the flag.

SSR is an 8-bit register containing status flags that indicate the operating status of the SCI, and multiprocessor bits.

SSR can be read or written to by the CPU at all times. However, 1 cannot be written to flags TDRE, RDRF, ORER, PER, and FER. Also note that in order to clear these flags they must be read as 1 beforehand. The TEND flag and MPB flag are read-only flags and cannot be modified.

SSR is initialized to H'84 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Transmit Data Register Empty (TDRE): Indicates that data has been transferred from TDR to TSR and the next serial data can be written to TDR.

Bit 7

| TDRE | Description |
|------|---|
| 0 | [Clearing conditions] <ul style="list-style-type: none"> When 0 is written in TDRE after reading TDRE = 1 When the DTC is activated by a TXI interrupt and writes data to TDR |
| 1 | [Setting conditions] (Initial value) <ul style="list-style-type: none"> When the TE bit in SCR is 0 When data is transferred from TDR to TSR and data can be written to TDR |

Bit 6—Receive Data Register Full (RDRF): Indicates that the received data is stored in RDR.

Bit 6

| RDRF | Description |
|------|---|
| 0 | [Clearing conditions] (Initial value) <ul style="list-style-type: none"> • When 0 is written in RDRF after reading RDRF = 1 • When the DTC is activated by an RXI interrupt and reads data from RDR |
| 1 | [Setting condition] When serial reception ends normally and receive data is transferred from RSR to RDR |

Note: RDR and the RDRF flag are not affected and retain their previous values when an error is detected during reception or when the RE bit in SCR is cleared to 0.

If reception of the next data is completed while the RDRF flag is still set to 1, an overrun error will occur and the receive data will be lost.

Bit 5—Overrun Error (ORER): Indicates that an overrun error occurred during reception, causing abnormal termination.

Bit 5

| ORER | Description |
|------|--|
| 0 | [Clearing condition] (Initial value)*1 When 0 is written in ORER after reading ORER = 1 |
| 1 | [Setting condition] When the next serial reception is completed while RDRF = 1*2 |

Notes: 1. The ORER flag is not affected and retains its previous state when the RE bit in SCR is cleared to 0.

2. The receive data prior to the overrun error is retained in RDR, and the data received subsequently is lost. Also, subsequent serial reception cannot be continued while the ORER flag is set to 1. In synchronous mode, serial transmission cannot be continued, either.

Bit 4—Framing Error (FER): Indicates that a framing error occurred during reception in asynchronous mode, causing abnormal termination.

Bit 4

| FER | Description |
|-----|---|
| 0 | [Clearing condition] (Initial value) ^{*1} When 0 is written in FER after reading FER = 1 |
| 1 | [Setting condition] When the SCI checks the stop bit at the end of the receive data when reception ends, and the stop bit is 0 ^{*2} |

- Notes:
1. The FER flag is not affected and retains its previous state when the RE bit in SCR is cleared to 0.
 2. In 2-stop-bit mode, only the first stop bit is checked for a value of 0; the second stop bit is not checked. If a framing error occurs, the receive data is transferred to RDR but the RDRF flag is not set. Also, subsequent serial reception cannot be continued while the FER flag is set to 1. In synchronous mode, serial transmission cannot be continued, either.

Bit 3—Parity Error (PER): Indicates that a parity error occurred during reception using parity addition in asynchronous mode, causing abnormal termination.

Bit 3

| PER | Description |
|-----|--|
| 0 | [Clearing condition] (Initial value) ^{*1} When 0 is written in PER after reading PER = 1 |
| 1 | [Setting condition] When, in reception, the number of 1 bits in the receive data plus the parity bit does not match the parity setting (even or odd) specified by the O/ \bar{E} bit in SMR ^{*2} |

- Notes:
1. The PER flag is not affected and retains its previous state when the RE bit in SCR is cleared to 0.
 2. If a parity error occurs, the receive data is transferred to RDR but the RDRF flag is not set. Also, subsequent serial reception cannot be continued while the PER flag is set to 1. In synchronous mode, serial transmission cannot be continued, either.

Bit 2—Transmit End (TEND): Indicates that there is no valid data in TDR when the last bit of the transmit character is sent, and transmission has been ended.

The TEND flag is read-only and cannot be modified.

Bit 2

| TEND | Description |
|------|---|
| 0 | [Clearing conditions] <ul style="list-style-type: none"> When 0 is written in TDRE after reading TDRE = 1 When the DTC is activated by a TXI interrupt and writes data to TDR |
| 1 | [Setting conditions] (Initial value) <ul style="list-style-type: none"> When the TE bit in SCR is 0 When TDRE = 1 at transmission of the last bit of a 1-byte serial transmit character |

Bit 1—Multiprocessor Bit (MPB): When reception is performed using a multiprocessor format in asynchronous mode, MPB stores the multiprocessor bit in the receive data.

MPB is a read-only bit, and cannot be modified.

Bit 1

| MPB | Description |
|-----|--|
| 0 | [Clearing condition] (Initial value)* When data with a 0 multiprocessor bit is received |
| 1 | [Setting condition] When data with a 1 multiprocessor bit is received |

Note: * Retains its previous state when the RE bit in SCR is cleared to 0 with multiprocessor format.

Bit 0—Multiprocessor Bit Transfer (MPBT): When transmission is performed using a multiprocessor format in asynchronous mode, MPBT stores the multiprocessor bit to be added to the transmit data.

The MPBT bit setting is invalid when a multiprocessor format is not used, when not transmitting, and in synchronous mode.

Bit 0

| MPBT | Description |
|------|---|
| 0 | Data with a 0 multiprocessor bit is transmitted (Initial value) |
| 1 | Data with a 1 multiprocessor bit is transmitted |

15.2.8 Bit Rate Register (BRR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

BRR is an 8-bit register that sets the serial transfer bit rate in accordance with the baud rate generator operating clock selected by bits CKS1 and CKS0 in SMR.

BRR can be read or written to by the CPU at all times.

BRR is initialized to H'FF by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

As baud rate generator control is performed independently for each channel, different values can be set for each channel.

Table 15.3 shows sample BRR settings in asynchronous mode, and table 15.4 shows sample BRR settings in synchronous mode.

Table 15.3 BRR Settings for Various Bit Rates (Asynchronous Mode)

| Bit Rate (bits/s) | Operating Frequency ϕ (MHz) | | | | | | | | | | | |
|----------------------|----------------------------------|-----|-----------|-----------------------|-----|-----------|---------------------|-----|-----------|----------------|-----|-----------|
| | $\phi = 2$ MHz | | | $\phi = 2.097152$ MHz | | | $\phi = 2.4576$ MHz | | | $\phi = 3$ MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 1 | 141 | 0.03 | 1 | 148 | -0.04 | 1 | 174 | -0.26 | 1 | 212 | 0.03 |
| 150 | 1 | 103 | 0.16 | 1 | 108 | 0.21 | 1 | 127 | 0.00 | 1 | 155 | 0.16 |
| 300 | 0 | 207 | 0.16 | 0 | 217 | 0.21 | 0 | 255 | 0.00 | 1 | 77 | 0.16 |
| 600 | 0 | 103 | 0.16 | 0 | 108 | 0.21 | 0 | 127 | 0.00 | 0 | 155 | 0.16 |
| 1200 | 0 | 51 | 0.16 | 0 | 54 | -0.70 | 0 | 63 | 0.00 | 0 | 77 | 0.16 |
| 2400 | 0 | 25 | 0.16 | 0 | 26 | 1.14 | 0 | 31 | 0.00 | 0 | 38 | 0.16 |
| 4800 | 0 | 12 | 0.16 | 0 | 13 | -2.48 | 0 | 15 | 0.00 | 0 | 19 | -2.34 |
| 9600 | — | — | — | 0 | 6 | -2.48 | 0 | 7 | 0.00 | 0 | 9 | -2.34 |
| 19200 | — | — | — | — | — | — | 0 | 3 | 0.00 | 0 | 4 | -2.34 |
| 31250 | 0 | 1 | 0.00 | — | — | — | — | — | — | 0 | 2 | 0.00 |
| 38400 | — | — | — | — | — | — | 0 | 1 | 0.00 | — | — | — |

| Bit Rate (bits/s) | Operating Frequency ϕ (MHz) | | | | | | | | | | | |
|----------------------|----------------------------------|-----|-----------|----------------|-----|-----------|---------------------|-----|-----------|----------------|-----|-----------|
| | $\phi = 3.6864$ MHz | | | $\phi = 4$ MHz | | | $\phi = 4.9152$ MHz | | | $\phi = 5$ MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 2 | 64 | 0.70 | 2 | 70 | 0.03 | 2 | 86 | 0.31 | 2 | 88 | -0.25 |
| 150 | 1 | 191 | 0.00 | 1 | 207 | 0.16 | 1 | 255 | 0.00 | 2 | 64 | 0.16 |
| 300 | 1 | 95 | 0.00 | 1 | 103 | 0.16 | 1 | 127 | 0.00 | 1 | 129 | 0.16 |
| 600 | 0 | 191 | 0.00 | 0 | 207 | 0.16 | 0 | 255 | 0.00 | 1 | 64 | 0.16 |
| 1200 | 0 | 95 | 0.00 | 0 | 103 | 0.16 | 0 | 127 | 0.00 | 0 | 129 | 0.16 |
| 2400 | 0 | 47 | 0.00 | 0 | 51 | 0.16 | 0 | 63 | 0.00 | 0 | 64 | 0.16 |
| 4800 | 0 | 23 | 0.00 | 0 | 25 | 0.16 | 0 | 31 | 0.00 | 0 | 32 | -1.36 |
| 9600 | 0 | 11 | 0.00 | 0 | 12 | 0.16 | 0 | 15 | 0.00 | 0 | 15 | 1.73 |
| 19200 | 0 | 5 | 0.00 | — | — | — | 0 | 7 | 0.00 | 0 | 7 | 1.73 |
| 31250 | — | — | — | 0 | 3 | 0.00 | 0 | 4 | -1.70 | 0 | 4 | 0.00 |
| 38400 | 0 | 2 | 0.00 | — | — | — | 0 | 3 | 0.00 | 0 | 3 | 1.73 |

Operating Frequency ϕ (MHz)

| Bit Rate (bits/s) | $\phi = 6$ MHz | | | $\phi = 6.144$ MHz | | | $\phi = 7.3728$ MHz | | | $\phi = 8$ MHz | | |
|----------------------|----------------|-----|-----------|--------------------|-----|-----------|---------------------|-----|-----------|----------------|-----|-----------|
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| | 110 | 2 | 106 | -0.44 | 2 | 108 | 0.08 | 2 | 130 | -0.07 | 2 | 141 |
| 150 | 2 | 77 | 0.16 | 2 | 79 | 0.00 | 2 | 95 | 0.00 | 2 | 103 | 0.16 |
| 300 | 1 | 155 | 0.16 | 1 | 159 | 0.00 | 1 | 191 | 0.00 | 1 | 207 | 0.16 |
| 600 | 1 | 77 | 0.16 | 1 | 79 | 0.00 | 1 | 95 | 0.00 | 1 | 103 | 0.16 |
| 1200 | 0 | 155 | 0.16 | 0 | 159 | 0.00 | 0 | 191 | 0.00 | 0 | 207 | 0.16 |
| 2400 | 0 | 77 | 0.16 | 0 | 79 | 0.00 | 0 | 95 | 0.00 | 0 | 103 | 0.16 |
| 4800 | 0 | 38 | 0.16 | 0 | 39 | 0.00 | 0 | 47 | 0.00 | 0 | 51 | 0.16 |
| 9600 | 0 | 19 | -2.34 | 0 | 19 | 0.00 | 0 | 23 | 0.00 | 0 | 25 | 0.16 |
| 19200 | 0 | 9 | -2.34 | 0 | 9 | 0.00 | 0 | 11 | 0.00 | 0 | 12 | 0.16 |
| 31250 | 0 | 5 | 0.00 | 0 | 5 | 2.40 | — | — | — | 0 | 7 | 0.00 |
| 38400 | 0 | 4 | -2.34 | 0 | 4 | 0.00 | 0 | 5 | 0.00 | — | — | — |

Operating Frequency ϕ (MHz)

| Bit Rate (bits/s) | $\phi = 9.8304$ MHz | | | $\phi = 10$ MHz | | | $\phi = 12$ MHz | | | $\phi = 12.288$ MHz | | |
|----------------------|---------------------|-----|-----------|-----------------|-----|-----------|-----------------|-----|-----------|---------------------|-----|-----------|
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| | 110 | 2 | 174 | -0.26 | 2 | 177 | -0.25 | 2 | 212 | 0.03 | 2 | 217 |
| 150 | 2 | 127 | 0.00 | 2 | 129 | 0.16 | 2 | 155 | 0.16 | 2 | 159 | 0.00 |
| 300 | 1 | 255 | 0.00 | 2 | 64 | 0.16 | 2 | 77 | 0.16 | 2 | 79 | 0.00 |
| 600 | 1 | 127 | 0.00 | 1 | 129 | 0.16 | 1 | 155 | 0.16 | 1 | 159 | 0.00 |
| 1200 | 0 | 255 | 0.00 | 1 | 64 | 0.16 | 1 | 77 | 0.16 | 1 | 79 | 0.00 |
| 2400 | 0 | 127 | 0.00 | 0 | 129 | 0.16 | 0 | 155 | 0.16 | 0 | 159 | 0.00 |
| 4800 | 0 | 63 | 0.00 | 0 | 64 | 0.16 | 0 | 77 | 0.16 | 0 | 79 | 0.00 |
| 9600 | 0 | 31 | 0.00 | 0 | 32 | -1.36 | 0 | 38 | 0.16 | 0 | 39 | 0.00 |
| 19200 | 0 | 15 | 0.00 | 0 | 15 | 1.73 | 0 | 19 | -2.34 | 0 | 19 | 0.00 |
| 31250 | 0 | 9 | -1.70 | 0 | 9 | 0.00 | 0 | 11 | 0.00 | 0 | 11 | 2.40 |
| 38400 | 0 | 7 | 0.00 | 0 | 7 | 1.73 | 0 | 9 | -2.34 | 0 | 9 | 0.00 |

Operating Frequency ϕ (MHz)

| Bit Rate (bits/s) | Operating Frequency ϕ (MHz) | | | | | | | | | | | |
|----------------------|----------------------------------|-----|-----------|----------------------|-----|-----------|-----------------|-----|-----------|----------------------|-----|-----------|
| | $\phi = 14$ MHz | | | $\phi = 14.7456$ MHz | | | $\phi = 16$ MHz | | | $\phi = 17.2032$ MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 2 | 248 | -0.17 | 3 | 64 | 0.70 | 3 | 70 | 0.03 | 3 | 75 | 0.48 |
| 150 | 2 | 181 | 0.16 | 2 | 191 | 0.00 | 2 | 207 | 0.16 | 2 | 223 | 0.00 |
| 300 | 2 | 90 | 0.16 | 2 | 95 | 0.00 | 2 | 103 | 0.16 | 2 | 111 | 0.00 |
| 600 | 1 | 181 | 0.16 | 1 | 191 | 0.00 | 1 | 207 | 0.16 | 1 | 223 | 0.00 |
| 1200 | 1 | 90 | 0.16 | 1 | 95 | 0.00 | 1 | 103 | 0.16 | 1 | 111 | 0.00 |
| 2400 | 0 | 181 | 0.16 | 0 | 191 | 0.00 | 0 | 207 | 0.16 | 0 | 223 | 0.00 |
| 4800 | 0 | 90 | 0.16 | 0 | 95 | 0.00 | 0 | 103 | 0.16 | 0 | 111 | 0.00 |
| 9600 | 0 | 45 | -0.93 | 0 | 47 | 0.00 | 0 | 51 | 0.16 | 0 | 55 | 0.00 |
| 19200 | 0 | 22 | -0.93 | 0 | 23 | 0.00 | 0 | 25 | 0.16 | 0 | 27 | 0.00 |
| 31250 | 0 | 13 | 0.00 | 0 | 14 | -1.70 | 0 | 15 | 0.00 | 0 | 16 | 1.20 |
| 38400 | — | — | — | 0 | 11 | 0.00 | 0 | 12 | 0.16 | 0 | 13 | 0.00 |

Operating Frequency ϕ (MHz)

| Bit Rate (bits/s) | Operating Frequency ϕ (MHz) | | | | | | | | |
|----------------------|----------------------------------|-----|-----------|----------------------|-----|-----------|-----------------|-----|-----------|
| | $\phi = 18$ MHz | | | $\phi = 19.6608$ MHz | | | $\phi = 20$ MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 3 | 79 | -0.12 | 3 | 86 | 0.31 | 3 | 88 | -0.25 |
| 150 | 2 | 233 | 0.16 | 2 | 255 | 0.00 | 3 | 64 | 0.16 |
| 300 | 2 | 116 | 0.16 | 2 | 127 | 0.00 | 2 | 129 | 0.16 |
| 600 | 1 | 233 | 0.16 | 1 | 255 | 0.00 | 2 | 64 | 0.16 |
| 1200 | 1 | 116 | 0.16 | 1 | 127 | 0.00 | 1 | 129 | 0.16 |
| 2400 | 0 | 233 | 0.16 | 0 | 255 | 0.00 | 1 | 64 | 0.16 |
| 4800 | 0 | 116 | 0.16 | 0 | 127 | 0.00 | 0 | 129 | 0.16 |
| 9600 | 0 | 58 | -0.69 | 0 | 63 | 0.00 | 0 | 64 | 0.16 |
| 19200 | 0 | 28 | 1.02 | 0 | 31 | 0.00 | 0 | 32 | -1.36 |
| 31250 | 0 | 17 | 0.00 | 0 | 19 | -1.70 | 0 | 19 | 0.00 |
| 38400 | 0 | 14 | -2.34 | 0 | 15 | 0.00 | 0 | 15 | 1.73 |

Table 15.4 BRR Settings for Various Bit Rates (Synchronous Mode)

| Bit Rate (bits/s) | Operating Frequency ϕ (MHz) | | | | | | | | | | | |
|----------------------|----------------------------------|-----|----------------|-----|----------------|-----|-----------------|-----|-----------------|-----|-----------------|-----|
| | $\phi = 2$ MHz | | $\phi = 4$ MHz | | $\phi = 8$ MHz | | $\phi = 10$ MHz | | $\phi = 16$ MHz | | $\phi = 20$ MHz | |
| | n | N | n | N | n | N | n | N | n | N | n | N |
| 110 | 3 | 70 | — | — | | | | | | | | |
| 250 | 2 | 124 | 2 | 249 | 3 | 124 | — | — | 3 | 249 | | |
| 500 | 1 | 249 | 2 | 124 | 2 | 249 | — | — | 3 | 124 | — | — |
| 1 k | 1 | 124 | 1 | 249 | 2 | 124 | — | — | 2 | 249 | — | — |
| 2.5 k | 0 | 199 | 1 | 99 | 1 | 199 | 1 | 249 | 2 | 99 | 2 | 124 |
| 5 k | 0 | 99 | 0 | 199 | 1 | 99 | 1 | 124 | 1 | 199 | 1 | 249 |
| 10 k | 0 | 49 | 0 | 99 | 0 | 199 | 0 | 249 | 1 | 99 | 1 | 124 |
| 25 k | 0 | 19 | 0 | 39 | 0 | 79 | 0 | 99 | 0 | 159 | 0 | 199 |
| 50 k | 0 | 9 | 0 | 19 | 0 | 39 | 0 | 49 | 0 | 79 | 0 | 99 |
| 100 k | 0 | 4 | 0 | 9 | 0 | 19 | 0 | 24 | 0 | 39 | 0 | 49 |
| 250 k | 0 | 1 | 0 | 3 | 0 | 7 | 0 | 9 | 0 | 15 | 0 | 19 |
| 500 k | 0 | 0* | 0 | 1 | 0 | 3 | 0 | 4 | 0 | 7 | 0 | 9 |
| 1 M | | | 0 | 0* | 0 | 1 | | | 0 | 3 | 0 | 4 |
| 2.5 M | | | | | | | 0 | 0* | | | 0 | 1 |
| 5 M | | | | | | | | | | | 0 | 0* |

Legend:

Blank: Cannot be set.

—: Can be set, but there will be a degree of error.

*: Continuous transfer is not possible.

Note: As far as possible, the setting should be made so that the error is no more than 1%.

The BRR setting is found from the following equations.

Asynchronous mode:

$$N = \frac{\phi}{64 \times 2^{2n-1} \times B} \times 10^6 - 1$$

Synchronous mode:

$$N = \frac{\phi}{8 \times 2^{2n-1} \times B} \times 10^6 - 1$$

Where B: Bit rate (bits/s)

N: BRR setting for baud rate generator ($0 \leq N \leq 255$)

ϕ : Operating frequency (MHz)

n: Baud rate generator input clock (n = 0 to 3)

(See the table below for the relation between n and the clock.)

| n | Clock | SMR Setting | |
|---|-----------|-------------|------|
| | | CKS1 | CKS0 |
| 0 | ϕ | 0 | 0 |
| 1 | $\phi/4$ | 0 | 1 |
| 2 | $\phi/16$ | 1 | 0 |
| 3 | $\phi/64$ | 1 | 1 |

The bit rate error in asynchronous mode is found from the following equation:

$$\text{Error (\%)} = \left\{ \frac{\phi \times 10^6}{(N + 1) \times B \times 64 \times 2^{2n-1}} - 1 \right\} \times 100$$

Table 15.5 shows the maximum bit rate for each frequency in asynchronous mode. Tables 15.6 and 15.7 show the maximum bit rates with external clock input.

Table 15.5 Maximum Bit Rate for Each Frequency (Asynchronous Mode)

| ϕ (MHz) | Maximum Bit Rate (bits/s) | n | N |
|--------------|---------------------------|---|---|
| 2 | 62500 | 0 | 0 |
| 2.097152 | 65536 | 0 | 0 |
| 2.4576 | 76800 | 0 | 0 |
| 3 | 93750 | 0 | 0 |
| 3.6864 | 115200 | 0 | 0 |
| 4 | 125000 | 0 | 0 |
| 4.9152 | 153600 | 0 | 0 |
| 5 | 156250 | 0 | 0 |
| 6 | 187500 | 0 | 0 |
| 6.144 | 192000 | 0 | 0 |
| 7.3728 | 230400 | 0 | 0 |
| 8 | 250000 | 0 | 0 |
| 9.8304 | 307200 | 0 | 0 |
| 10 | 312500 | 0 | 0 |
| 12 | 375000 | 0 | 0 |
| 12.288 | 384000 | 0 | 0 |
| 14 | 437500 | 0 | 0 |
| 14.7456 | 460800 | 0 | 0 |
| 16 | 500000 | 0 | 0 |
| 17.2032 | 537600 | 0 | 0 |
| 18 | 562500 | 0 | 0 |
| 19.6608 | 614400 | 0 | 0 |
| 20 | 625000 | 0 | 0 |

Table 15.6 Maximum Bit Rate with External Clock Input (Asynchronous Mode)

| ϕ (MHz) | External Input Clock (MHz) | Maximum Bit Rate (bits/s) |
|--------------|----------------------------|---------------------------|
| 2 | 0.5000 | 31250 |
| 2.097152 | 0.5243 | 32768 |
| 2.4576 | 0.6144 | 38400 |
| 3 | 0.7500 | 46875 |
| 3.6864 | 0.9216 | 57600 |
| 4 | 1.0000 | 62500 |
| 4.9152 | 1.2288 | 76800 |
| 5 | 1.2500 | 78125 |
| 6 | 1.5000 | 93750 |
| 6.144 | 1.5360 | 96000 |
| 7.3728 | 1.8432 | 115200 |
| 8 | 2.0000 | 125000 |
| 9.8304 | 2.4576 | 153600 |
| 10 | 2.5000 | 156250 |
| 12 | 3.0000 | 187500 |
| 12.288 | 3.0720 | 192000 |
| 14 | 3.5000 | 218750 |
| 14.7456 | 3.6864 | 230400 |
| 16 | 4.0000 | 250000 |
| 17.2032 | 4.3008 | 268800 |
| 18 | 4.5000 | 281250 |
| 19.6608 | 4.9152 | 307200 |
| 20 | 5.0000 | 312500 |

Table 15.7 Maximum Bit Rate with External Clock Input (Synchronous Mode)

| ϕ (MHz) | External Input Clock (MHz) | Maximum Bit Rate (bits/s) |
|--------------|----------------------------|---------------------------|
| 2 | 0.3333 | 333333.3 |
| 4 | 0.6667 | 666666.7 |
| 6 | 1.0000 | 1000000.0 |
| 8 | 1.3333 | 1333333.3 |
| 10 | 1.6667 | 1666666.7 |
| 12 | 2.0000 | 2000000.0 |
| 14 | 2.3333 | 2333333.3 |
| 16 | 2.6667 | 2666666.7 |
| 18 | 3.0000 | 3000000.0 |
| 20 | 3.3333 | 3333333.3 |

15.2.9 Serial Interface Mode Register (SCMR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|------|------|---|------|
| | — | — | — | — | SDIR | SINV | — | SMIF |
| Initial value | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0 |
| Read/Write | — | — | — | — | R/W | R/W | — | R/W |

SCMR is an 8-bit readable/writable register used to select SCI functions.

SCMR is initialized to H'F2 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 7 to 4—Reserved: These bits cannot be modified and are always read as 1.

Bit 3—Data Transfer Direction (SDIR): Selects the serial/parallel conversion format.

Bit 3

| SDIR | Description |
|------|--|
| 0 | TDR contents are transmitted LSB-first Receive data is stored in RDR LSB-first (Initial value) |
| 1 | TDR contents are transmitted MSB-first Receive data is stored in RDR MSB-first |

Bit 2—Data Invert (SINV): Specifies inversion of the data logic level. The SINV bit does not affect the logic level of the parity bit(s); parity bit inversion requires inversion of the O/\bar{E} bit in SMR.

Bit 2

| SINV | Description | |
|------|---|-----------------|
| 0 | TDR contents are transmitted without modification Receive data is stored in RDR without modification | (Initial value) |
| 1 | TDR contents are inverted before being transmitted Receive data is stored in RDR in inverted form | |

Bit 1—Reserved: This bit cannot be modified and is always read as 1.

Bit 0—Serial Communication Interface Mode Select (SMIF): Reserved bit. 1 should not be written in this bit.

Bit 0

| SMIF | Description | |
|------|-----------------|-----------------|
| 0 | Normal SCI mode | (Initial value) |
| 1 | Reserved mode | |

15.2.10 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When bit MSTP7, MSTP6, or MSTP5 is set to 1, SCI0, SCI1, or SCI2 operation, respectively, stops at the end of the bus cycle and a transition is made to module stop mode. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRL Bit 7—Module Stop (MSTP7): Specifies the SCI0 module stop mode.

**MSTPCRL
Bit 7**

| MSTP7 | Description |
|--------------|--|
| 0 | SCI0 module stop mode is cleared |
| 1 | SCI0 module stop mode is set (Initial value) |

MSTPCRL Bit 6—Module Stop (MSTP6): Specifies the SCI1 module stop mode.

**MSTPCRL
Bit 6**

| MSTP6 | Description |
|--------------|--|
| 0 | SCI1 module stop mode is cleared |
| 1 | SCI1 module stop mode is set (Initial value) |

MSTPCRL Bit 5—Module Stop (MSTP5): Specifies the SCI2 module stop mode.

**MSTPCRL
Bit 5**

| MSTP5 | Description |
|--------------|--|
| 0 | SCI2 module stop mode is cleared |
| 1 | SCI2 module stop mode is set (Initial value) |

15.2.11 Keyboard Comparator Control Register (KBCOMP)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|--------|--------|--------|-------|-------|-------|-------|
| | IrE | IrCKS2 | IrCKS1 | IrCKS0 | KBADE | KBCH2 | KBCH1 | KBCH0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

KBCOMP is an 8-bit readable/writable register that selects the functions of SCI2 and the A/D converter.

KBCOMP is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—IrDA Enable (IrE): Specifies normal SCI operation or IrDA operation for SCI2 input/output.

Bit 7

| IrE | Description |
|-----|--|
| 0 | The TxD2/IrTxD and RxD2/IrRxD pins function as TxD2 and RxD2 (Initial value) |
| 1 | The TxD2/IrTxD and RxD2/IrRxD pins function as IrTxD and IrRxD |

Bits 6 to 4—IrDA Clock Select 2 to 0 (IrCKS2 to IrCKS0): These bits specify the high pulse width in IrTxD output pulse encoding when the IrDA function is enabled.

| Bit 6 | Bit 5 | Bit 4 | Description |
|--------|--------|--------|--|
| IrCKS2 | IrCKS1 | IrCKS0 | |
| 0 | 0 | 0 | $B \times 3/16$ (3/16 of the bit rate) (Initial value) |
| | | 1 | $\phi/2$ |
| | 1 | 0 | $\phi/4$ |
| | | 1 | $\phi/8$ |
| 1 | 0 | 0 | $\phi/16$ |
| | | 1 | $\phi/32$ |
| | 1 | 0 | $\phi/64$ |
| | | 1 | $\phi/128$ |

Bits 3 to 0—Keyboard Comparator Control: See the description in section 19, A/D converter.

15.3 Operation

15.3.1 Overview

The SCI can carry out serial communication in two modes: asynchronous mode in which synchronization is achieved character by character, and synchronous mode in which synchronization is achieved with clock pulses.

Selection of asynchronous or synchronous mode and the transmission format is made using SMR as shown in table 15.8. The SCI clock is determined by a combination of the C/\overline{A} bit in SMR and the CKE1 and CKE0 bits in SCR, as shown in table 15.9.

Asynchronous Mode

- Data length: Choice of 7 or 8 bits
- Choice of parity addition, multiprocessor bit addition, and addition of 1 or 2 stop bits (the combination of these parameters determines the transfer format and character length)
- Detection of framing, parity, and overrun errors, and breaks, during reception
- Choice of internal or external clock as SCI clock source
 - When internal clock is selected:

The SCI operates on the baud rate generator clock and a clock with the same frequency as the bit rate can be output
 - When external clock is selected:

A clock with a frequency of 16 times the bit rate must be input (the on-chip baud rate generator is not used)

Synchronous Mode

- Transfer format: Fixed 8-bit data
- Detection of overrun errors during reception
- Choice of internal or external clock as SCI clock source
 - When internal clock is selected:

The SCI operates on the baud rate generator clock and a serial clock is output off-chip
 - When external clock is selected:

The on-chip baud rate generator is not used, and the SCI operates on the input serial clock

Table 15.8 SMR Settings and Serial Transfer Format Selection

| SMR Settings | | | | | | SCI Transfer Format | | | | | | |
|------------------|-------|-------|-------|-------|-------------------|---------------------|---------------------|------------|--|------------|-----|--------|
| Bit 7 | Bit 6 | Bit 2 | Bit 5 | Bit 3 | Mode | Data Length | Multi-processor Bit | Parity Bit | Stop Bit Length | | | |
| $\overline{C/A}$ | CHR | MP | PE | STOP | | | | | | | | |
| 0 | 0 | 0 | 0 | 0 | Asynchronous mode | 8-bit data | No | No | 1 bit | | | |
| | | | | 1 | | | | | 2 bits | | | |
| | | | | 1 | 0 | | | | Asynchronous mode (multi-processor format) | 7-bit data | No | 1 bit |
| | | | | | 1 | | | | | | | 2 bits |
| | | | | 1 | 0 | | | | Asynchronous mode (multi-processor format) | 7-bit data | Yes | 1 bit |
| | | | | | 1 | | | | | | | 2 bits |
| 1 | — | — | — | — | Synchronous mode | 8-bit data | No | None | | | | |

Table 15.9 SMR and SCR Settings and SCI Clock Source Selection

| SMR | | SCR Setting | | SCI Transfer Clock | |
|------------------|-------|-------------|-------------------|--------------------|---|
| Bit 7 | Bit 1 | Bit 0 | Mode | Clock Source | SCK Pin Function |
| $\overline{C/A}$ | CKE1 | CKE0 | | | |
| 0 | 0 | 0 | Asynchronous mode | Internal | SCI does not use SCK pin Outputs clock with same frequency as bit rate |
| | | 1 | | | |
| 1 | 0 | 0 | Synchronous mode | Internal | Outputs serial clock |
| | | 1 | | | |
| 1 | 1 | 0 | Synchronous mode | External | Inputs serial clock |
| | | 1 | | | |

15.3.2 Operation in Asynchronous Mode

In asynchronous mode, characters are sent or received, each preceded by a start bit indicating the start of communication and followed by one or two stop bits indicating the end of communication. Serial communication is thus carried out with synchronization established on a character-by-character basis.

Inside the SCI, the transmitter and receiver are independent units, enabling full-duplex communication. Both the transmitter and the receiver also have a double-buffered structure, so that data can be read or written during transmission or reception, enabling continuous data transfer.

Figure 15.2 shows the general format for asynchronous serial communication.

In asynchronous serial communication, the transmission line is usually held in the mark state (high level). The SCI monitors the transmission line, and when it goes to the space state (low level), recognizes a start bit and starts serial communication.

One serial communication character consists of a start bit (low level), followed by data (in LSB-first order), a parity bit (high or low level), and finally one or two stop bits (high level).

In asynchronous mode, the SCI performs synchronization at the falling edge of the start bit in reception. The SCI samples the data on the 8th pulse of a clock with a frequency of 16 times the length of one bit, so that the transfer data is latched at the center of each bit.

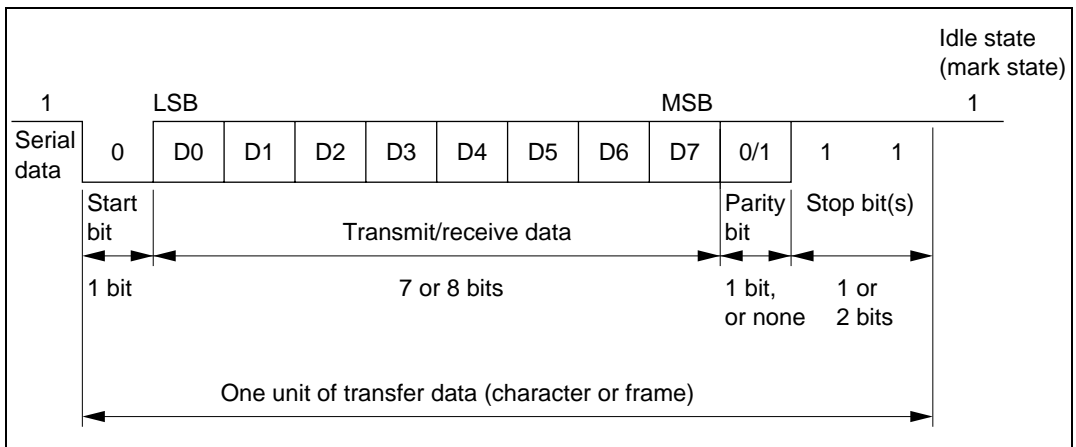


Figure 15.2 Data Format in Asynchronous Communication
(Example with 8-Bit Data, Parity, Two Stop Bits)

Data Transfer Format

Table 15.10 shows the data transfer formats that can be used in asynchronous mode. Any of 12 transfer formats can be selected by settings in SMR.

Table 15.10 Serial Transfer Formats (Asynchronous Mode)

| SMR Settings | | | | Serial Transfer Format and Frame Length | | | | | | | | | | | | |
|--------------|----|----|------|---|------------|---|---|---|---|---|---|------|------|------|------|--|
| CHR | PE | MP | STOP | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | |
| 0 | 0 | 0 | 0 | S | 8-bit data | | | | | | | | STOP | | | |
| 0 | 0 | 0 | 1 | S | 8-bit data | | | | | | | | STOP | STOP | | |
| 0 | 1 | 0 | 0 | S | 8-bit data | | | | | | | | P | STOP | | |
| 0 | 1 | 0 | 1 | S | 8-bit data | | | | | | | | P | STOP | STOP | |
| 1 | 0 | 0 | 0 | S | 7-bit data | | | | | | | STOP | | | | |
| 1 | 0 | 0 | 1 | S | 7-bit data | | | | | | | STOP | STOP | | | |
| 1 | 1 | 0 | 0 | S | 7-bit data | | | | | | | P | STOP | | | |
| 1 | 1 | 0 | 1 | S | 7-bit data | | | | | | | P | STOP | STOP | | |
| 0 | — | 1 | 0 | S | 8-bit data | | | | | | | | MPB | STOP | | |
| 0 | — | 1 | 1 | S | 8-bit data | | | | | | | | MPB | STOP | STOP | |
| 1 | — | 1 | 0 | S | 7-bit data | | | | | | | MPB | STOP | | | |
| 1 | — | 1 | 1 | S | 7-bit data | | | | | | | MPB | STOP | STOP | | |

Legend:

S: Start bit

STOP: Stop bit

P: Parity bit

MPB: Multiprocessor bit

Clock

Either an internal clock generated by the on-chip baud rate generator or an external clock input at the SCK pin can be selected as the SCI's serial clock, according to the setting of the C/\bar{A} bit in SMR and the CKE1 and CKE0 bits in SCR. For details of SCI clock source selection, see table 15.9.

When an external clock is input at the SCK pin, the clock frequency should be 16 times the bit rate used.

When the SCI is operated on an internal clock, the clock can be output from the SCK pin. The frequency of the clock output in this case is equal to the bit rate, and the phase is such that the rising edge of the clock is at the center of each transmit data bit, as shown in figure 15.3.

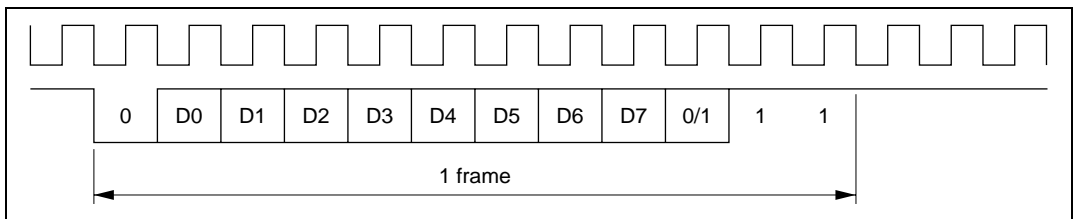


Figure 15.3 Relation between Output Clock and Transfer Data Phase (Asynchronous Mode)

Data Transfer Operations

SCI Initialization (Asynchronous Mode): Before transmitting and receiving data, first clear the TE and RE bits in SCR to 0, then initialize the SCI as described below.

When the operating mode, transfer format, etc., is changed, the TE and RE bits must be cleared to 0 before making the change using the following procedure. When the TE bit is cleared to 0, the TDRE flag is set to 1 and TSR is initialized. Note that clearing the RE bit to 0 does not change the contents of the RDRF, PER, FER, and ORER flags, or the contents of RDR.

When an external clock is used the clock should not be stopped during operation, including initialization, since operation is uncertain.

Figure 15.4 shows a sample SCI initialization flowchart.

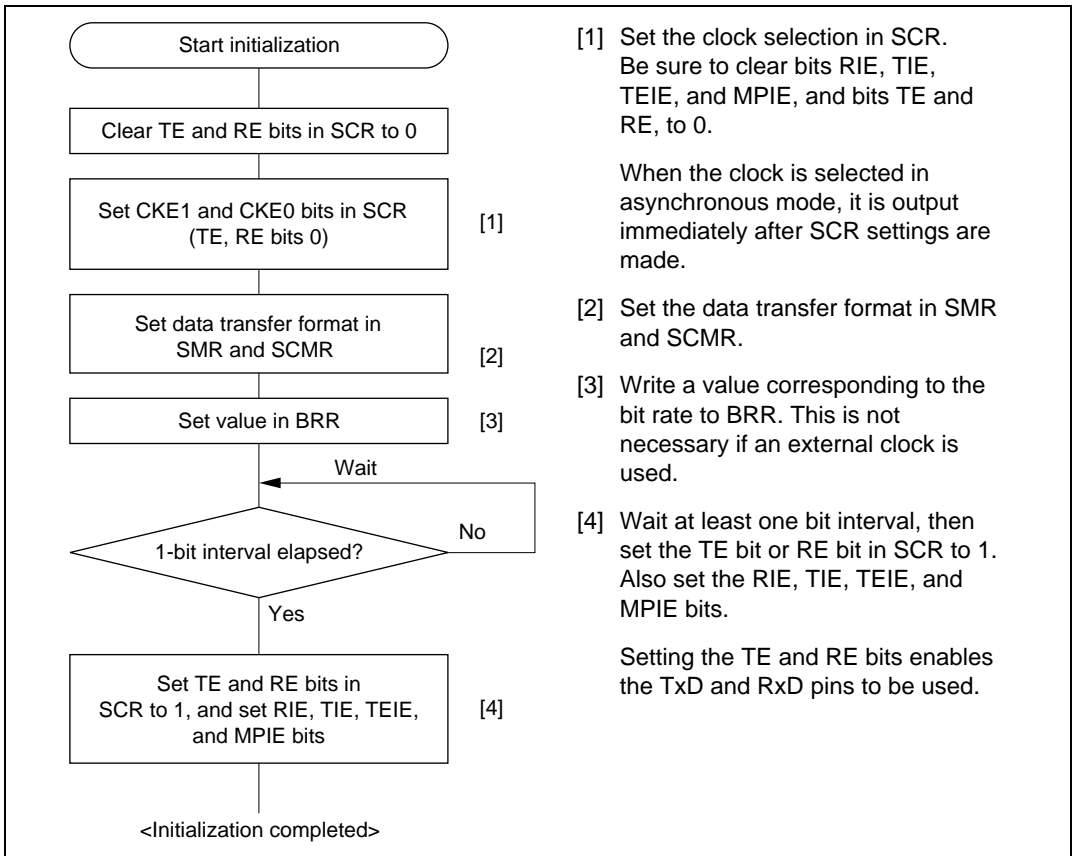


Figure 15.4 Sample SCI Initialization Flowchart

Serial Data Transmission (Asynchronous Mode): Figure 15.5 shows a sample flowchart for serial transmission.

The following procedure should be used for serial data transmission.

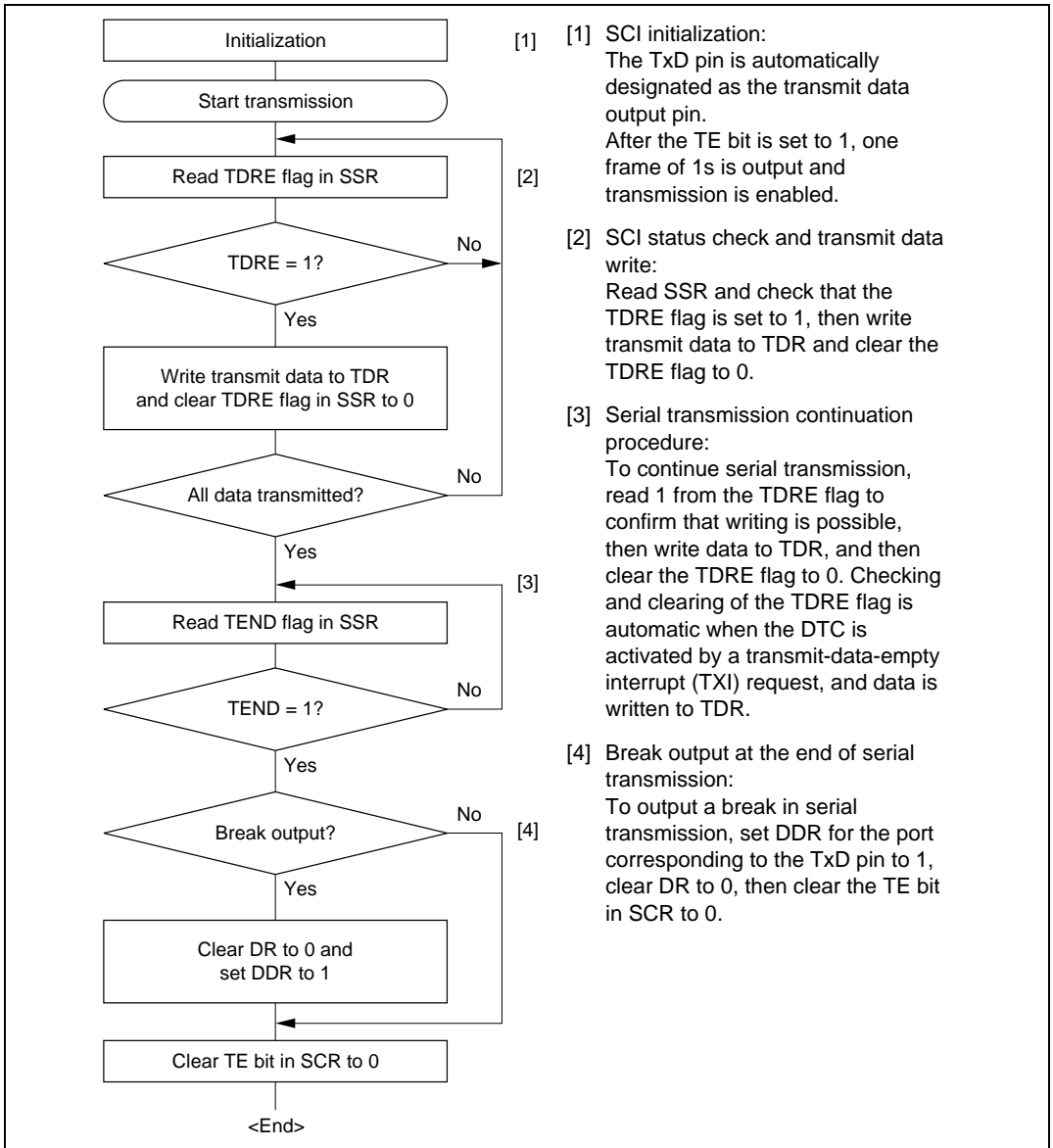


Figure 15.5 Sample Serial Transmission Flowchart

In serial transmission, the SCI operates as described below.

1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
 2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission.

If the TIE bit is set to 1 at this time, a transmit data empty interrupt (TXI) is generated. The serial transmit data is sent from the TxD pin in the following order.

 - a. Start bit:

One 0-bit is output.
 - b. Transmit data:

8-bit or 7-bit data is output in LSB-first order.
 - c. Parity bit or multiprocessor bit:

One parity bit (even or odd parity), or one multiprocessor bit is output.
A format in which neither a parity bit nor a multiprocessor bit is output can also be selected.
 - d. Stop bit(s):

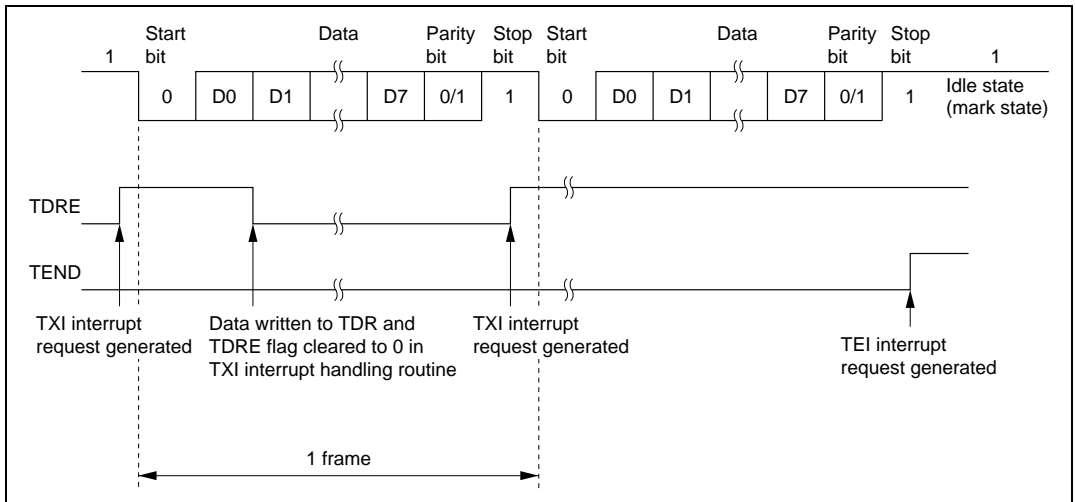
One or two 1-bits (stop bits) are output.
 - e. Mark state:

1 is output continuously until the start bit that starts the next transmission is sent.
3. The SCI checks the TDRE flag at the timing for sending the stop bit.

If the TDRE flag is cleared to 0, the data is transferred from TDR to TSR, the stop bit is sent, and then serial transmission of the next frame is started.

If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, the stop bit is sent, and then the mark state is entered in which 1 is output continuously. If the TEIE bit in SCR is set to 1 at this time, a TEI interrupt request is generated.

Figure 15.6 shows an example of the operation for transmission in asynchronous mode.



**Figure 15.6 Example of Operation in Transmission in Asynchronous Mode
(Example with 8-Bit Data, Parity, One Stop Bit)**

Serial Data Reception (Asynchronous Mode): Figure 15.7 shows a sample flowchart for serial reception.

The following procedure should be used for serial data reception.

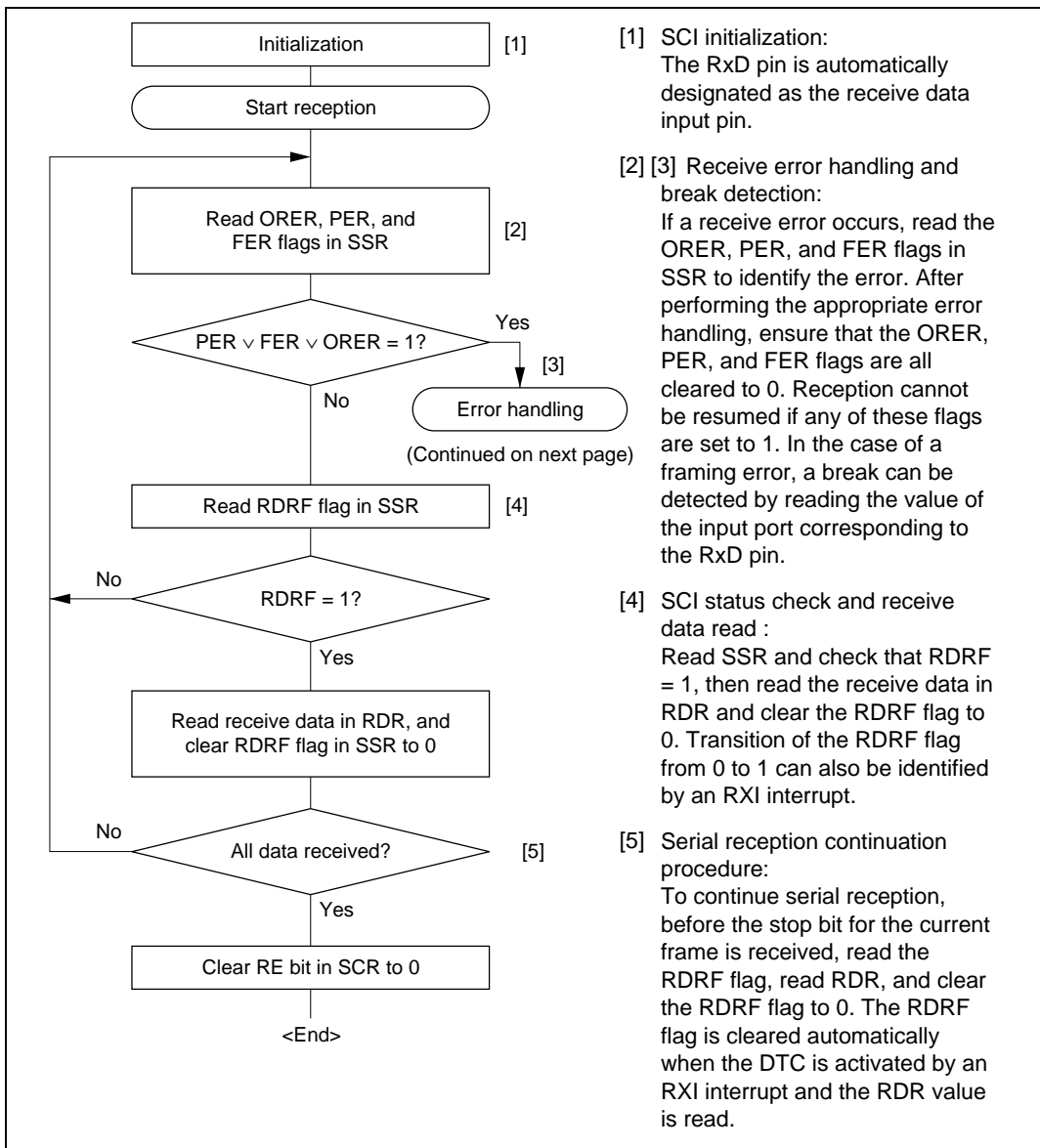


Figure 15.7 Sample Serial Reception Data Flowchart

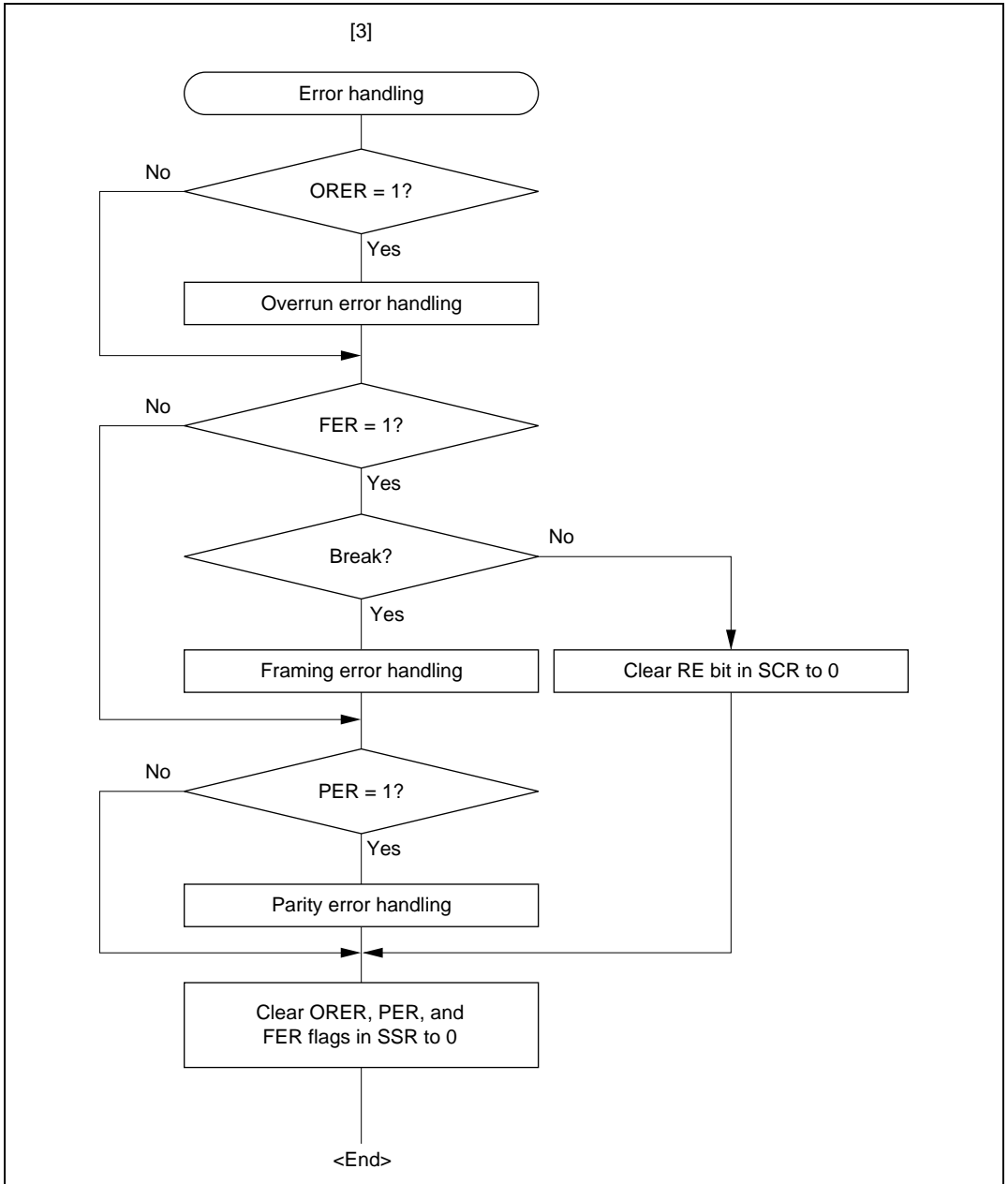


Figure 15.7 Sample Serial Reception Data Flowchart (cont)

In serial reception, the SCI operates as described below.

1. The SCI monitors the transmission line, and if a 0 stop bit is detected, performs internal synchronization and starts reception.
2. The received data is stored in RSR in LSB-to-MSB order.
3. The parity bit and stop bit are received.

After receiving these bits, the SCI carries out the following checks.

a. Parity check:

The SCI checks whether the number of 1 bits in the receive data agrees with the parity (even or odd) set in the O/\bar{E} bit in SMR.

b. Stop bit check:

The SCI checks whether the stop bit is 1.

If there are two stop bits, only the first is checked.

c. Status check:

The SCI checks whether the RDRF flag is 0, indicating that the receive data can be transferred from RSR to RDR.

If all the above checks are passed, the RDRF flag is set to 1, and the receive data is stored in RDR.

If a receive error* is detected in the error check, the operation is as shown in table 15.11.

Note: * Subsequent receive operations cannot be performed when a receive error has occurred.

Also note that the RDRF flag is not set to 1 in reception, and so the error flags must be cleared to 0.

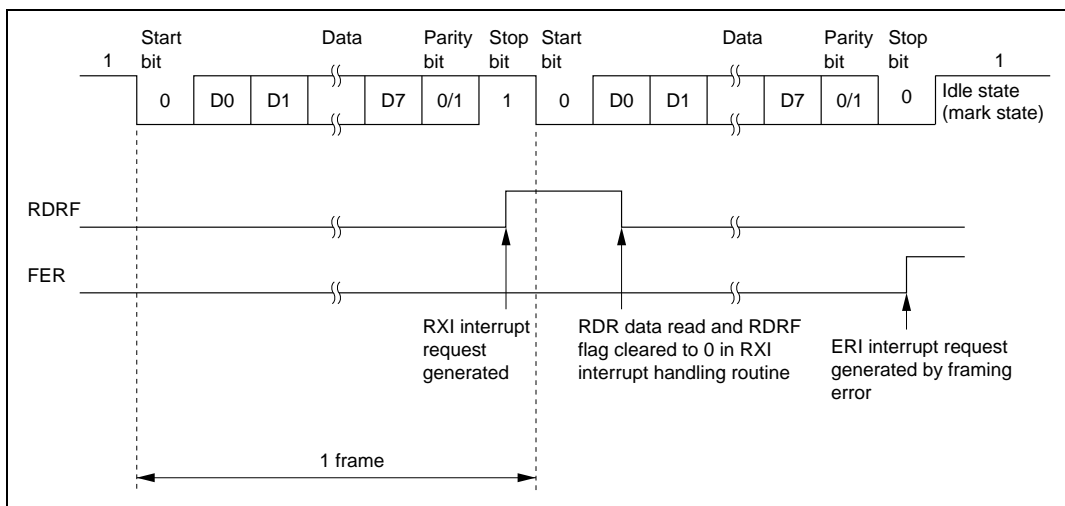
4. If the RIE bit in SCR is set to 1 when the RDRF flag changes to 1, a receive-data-full interrupt (RXI) request is generated.

Also, if the RIE bit in SCR is set to 1 when the ORER, PER, or FER flag changes to 1, a receive-error interrupt (ERI) request is generated.

Table 15.11 Receive Errors and Conditions for Occurrence

| Receive Error | Abbreviation | Occurrence Condition | Data Transfer |
|---------------|--------------|--|---|
| Overrun error | ORER | When the next data reception is completed while the RDRF flag in SSR is set to 1 | Receive data is not transferred from RSR to RDR |
| Framing error | FER | When the stop bit is 0 | Receive data is transferred from RSR to RDR |
| Parity error | PER | When the received data differs from the parity (even or odd) set in SMR | Receive data is transferred from RSR to RDR |

Figure 15.8 shows an example of the operation for reception in asynchronous mode.



**Figure 15.8 Example of SCI Operation in Reception
(Example with 8-Bit Data, Parity, One Stop Bit)**

15.3.3 Multiprocessor Communication Function

The multiprocessor communication function performs serial communication using a multiprocessor format, in which a multiprocessor bit is added to the transfer data, in asynchronous mode. Use of this function enables data transfer to be performed among a number of processors sharing transmission lines.

When multiprocessor communication is carried out, each receiving station is addressed by a unique ID code.

The serial communication cycle consists of two component cycles: an ID transmission cycle which specifies the receiving station, and a data transmission cycle. The multiprocessor bit is used to differentiate between the ID transmission cycle and the data transmission cycle.

The transmitting station first sends the ID of the receiving station with which it wants to perform serial communication as data with a 1 multiprocessor bit added. It then sends transmit data as data with a 0 multiprocessor bit added.

The receiving station skips the data until data with a 1 multiprocessor bit is sent.

When data with a 1 multiprocessor bit is received, the receiving station compares that data with its own ID. The station whose ID matches then receives the data sent next. Stations whose ID does not match continue to skip the data until data with a 1 multiprocessor bit is again received. In this way, data communication is carried out among a number of processors.

Figure 15.9 shows an example of inter-processor communication using a multiprocessor format.

Data Transfer Format

There are four data transfer formats.

When a multiprocessor format is specified, the parity bit specification is invalid.

For details, see table 15.10.

Clock

See the section on asynchronous mode.

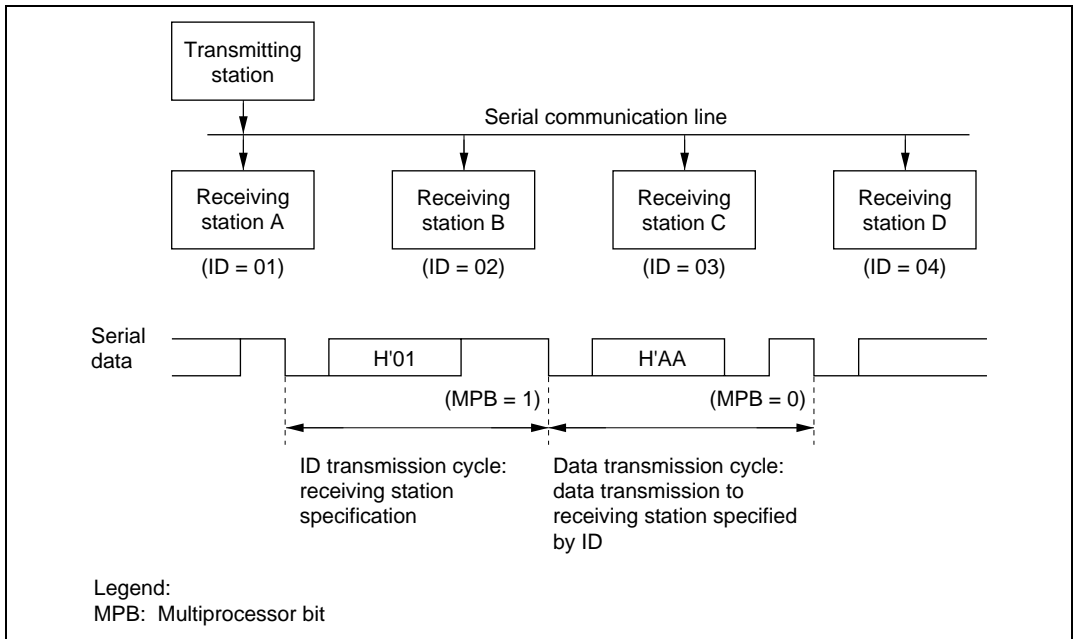


Figure 15.9 Example of Inter-Processor Communication Using Multiprocessor Format (Transmission of Data H'AA to Receiving Station A)

Data Transfer Operations

Multiprocessor Serial Data Transmission: Figure 15.10 shows a sample flowchart for multiprocessor serial data transmission.

The following procedure should be used for multiprocessor serial data transmission.

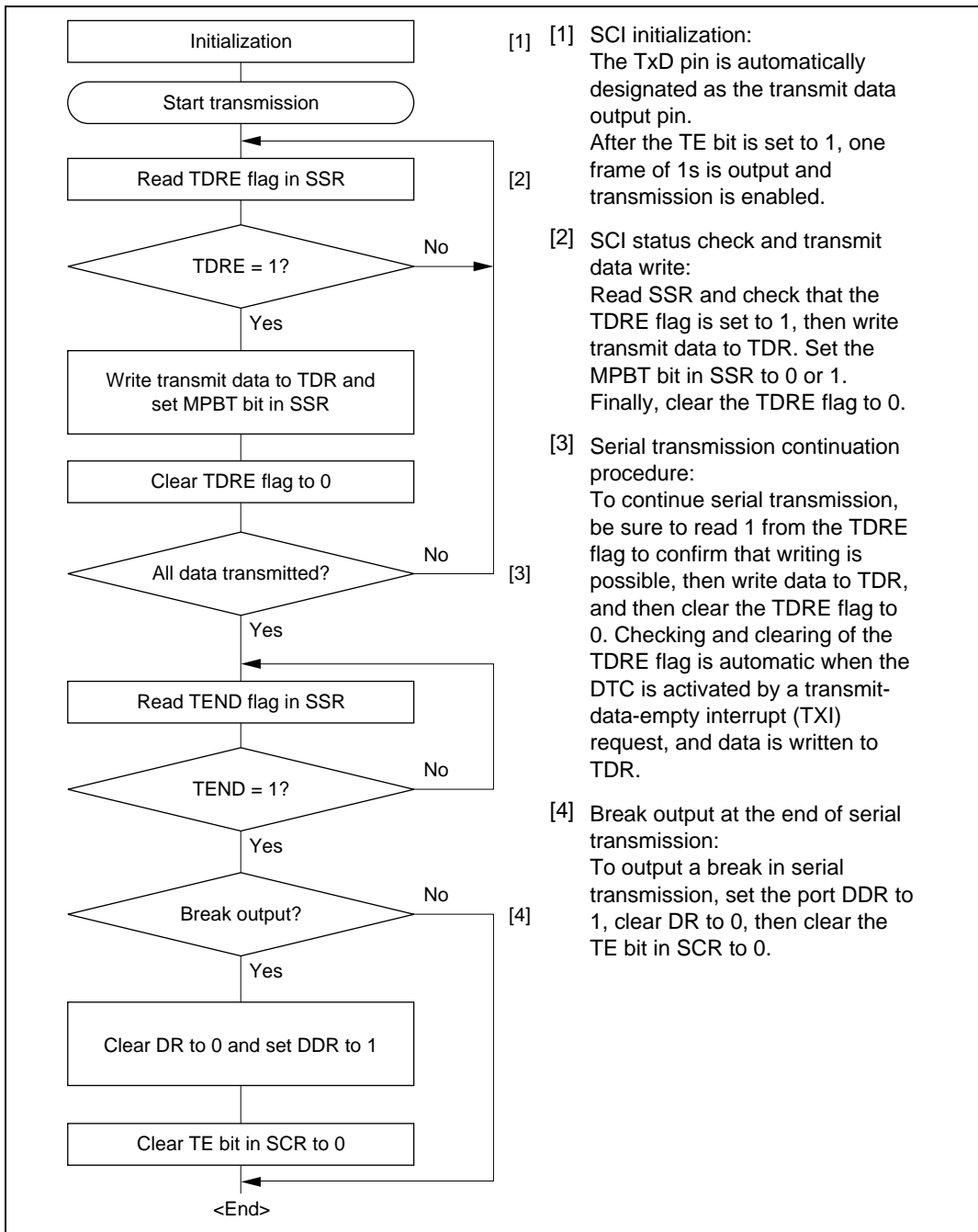


Figure 15.10 Sample Multiprocessor Serial Transmission Flowchart

In serial transmission, the SCI operates as described below.

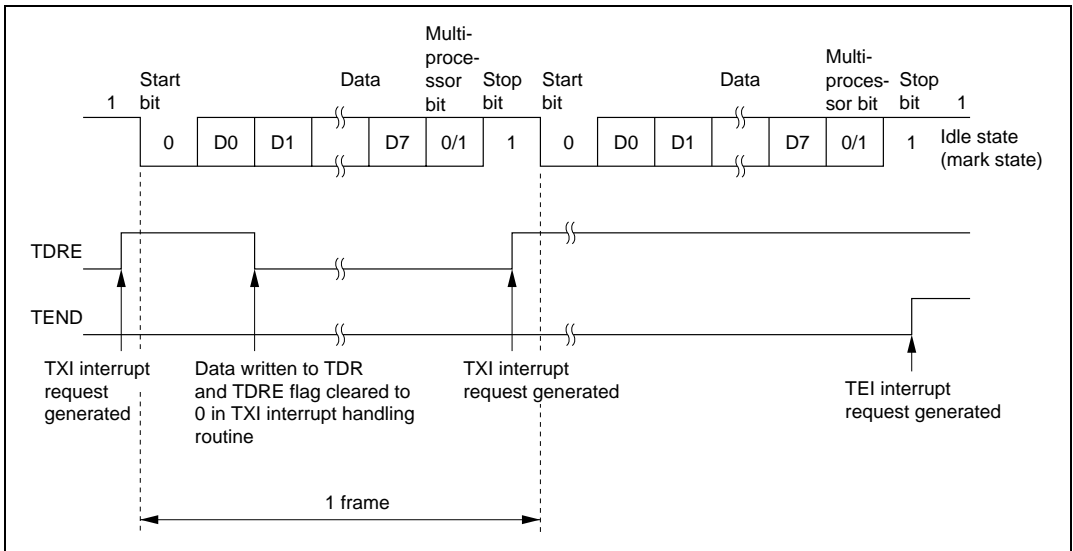
1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission.

If the TIE bit is set to 1 at this time, a transmit-data-empty interrupt (TXI) is generated.

The serial transmit data is sent from the TxD pin in the following order.

- a. Start bit:
One 0-bit is output.
 - b. Transmit data:
8-bit or 7-bit data is output in LSB-first order.
 - c. Multiprocessor bit
One multiprocessor bit (MPBT value) is output.
 - d. Stop bit(s):
One or two 1-bits (stop bits) are output.
 - e. Mark state:
1 is output continuously until the start bit that starts the next transmission is sent.
3. The SCI checks the TDRE flag at the timing for sending the stop bit.
If the TDRE flag is cleared to 0, data is transferred from TDR to TSR, the stop bit is sent, and then serial transmission of the next frame is started.
If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, the stop bit is sent, and then the mark state is entered in which 1 is output continuously. If the TEIE bit in SCR is set to 1 at this time, a transmit-end interrupt (TEI) request is generated.

Figure 15.11 shows an example of SCI operation for transmission using a multiprocessor format.



**Figure 15.11 Example of SCI Operation in Transmission
(Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit)**

Multiprocessor Serial Data Reception: Figure 15.12 shows a sample flowchart for multiprocessor serial reception.

The following procedure should be used for multiprocessor serial data reception.

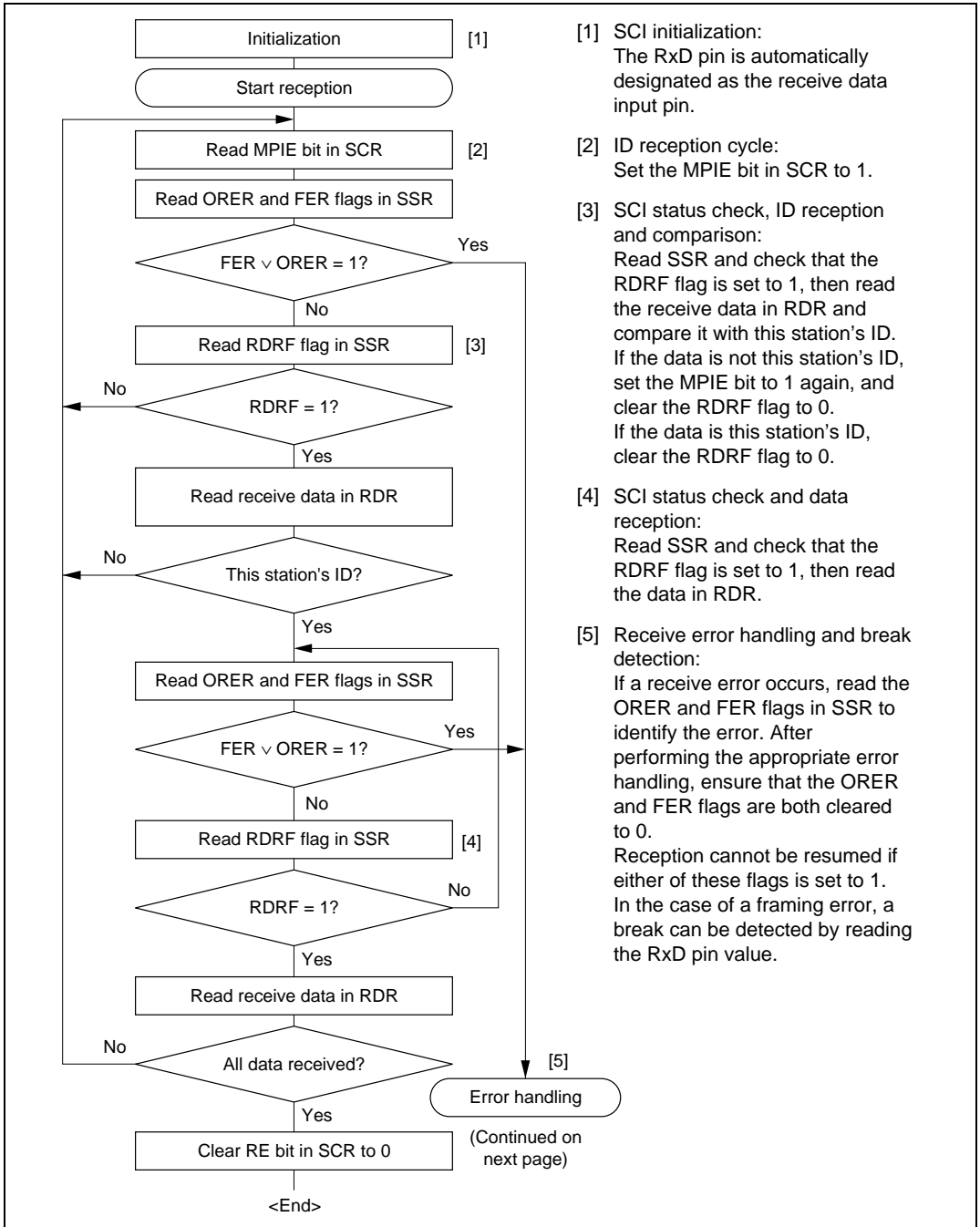


Figure 15.12 Sample Multiprocessor Serial Reception Flowchart

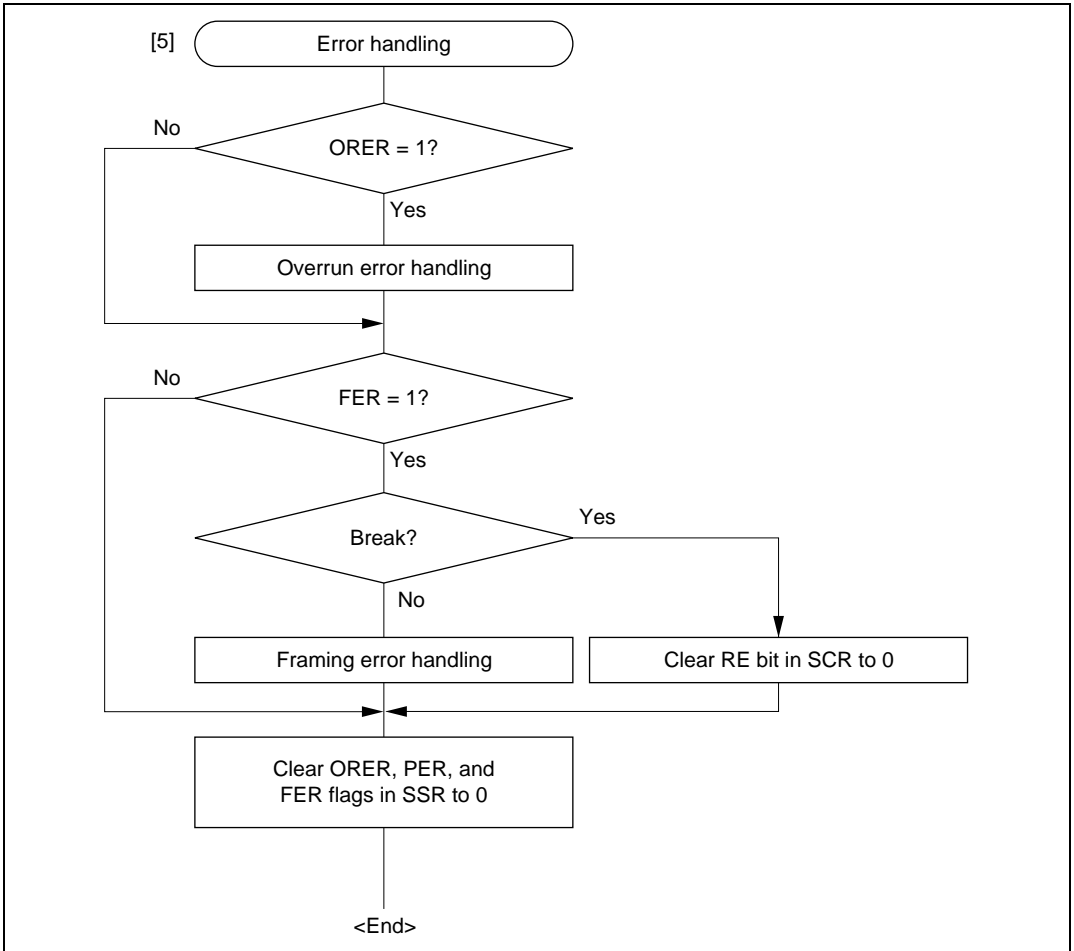
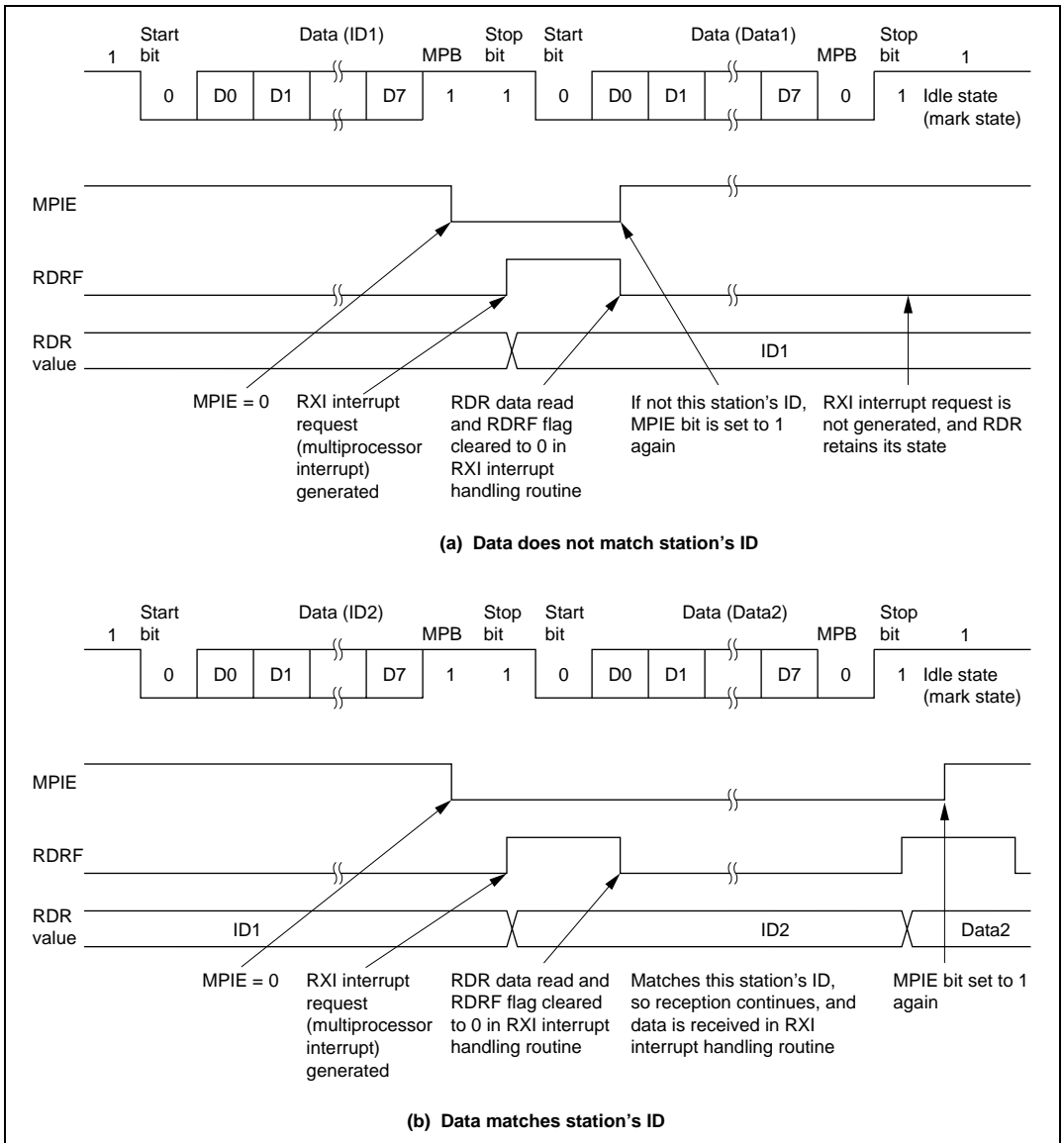
**Figure 15.12 Sample Multiprocessor Serial Reception Flowchart (cont)**

Figure 15.13 shows an example of SCI operation for multiprocessor format reception.



**Figure 15.13 Example of SCI Operation in Reception
(Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit)**

15.3.4 Operation in Synchronous Mode

In synchronous mode, data is transmitted or received in synchronization with clock pulses, making it suitable for high-speed serial communication.

Inside the SCI, the transmitter and receiver are independent units, enabling full-duplex communication by use of a common clock. Both the transmitter and the receiver also have a double-buffered structure, so that data can be read or written during transmission or reception, enabling continuous data transfer.

Figure 15.14 shows the general format for synchronous serial communication.

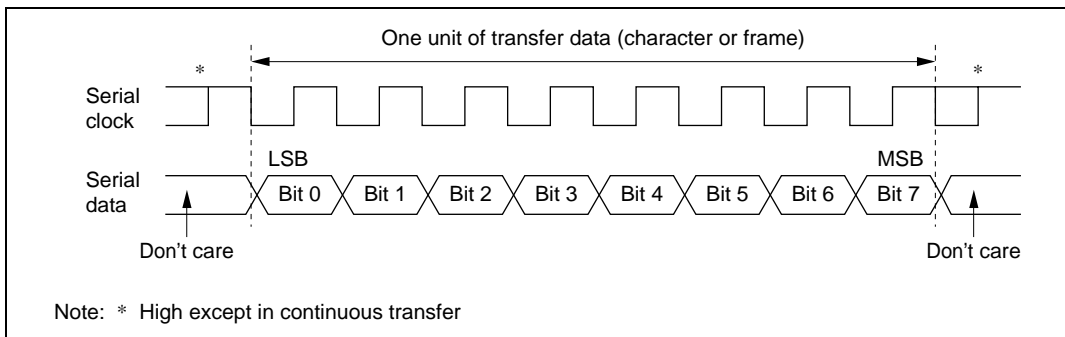


Figure 15.14 Data Format in Synchronous Communication

In synchronous serial communication, data on the transmission line is output from one falling edge of the serial clock to the next. Data is guaranteed valid at the rising edge of the serial clock.

In synchronous serial communication, one character consists of data output starting with the LSB and ending with the MSB. After the MSB is output, the transmission line holds the MSB state.

In synchronous mode, the SCI receives data in synchronization with the rising edge of the serial clock.

Data Transfer Format

A fixed 8-bit data format is used.

No parity or multiprocessor bits are added.

Clock

Either an internal clock generated by the on-chip baud rate generator or an external serial clock input at the SCK pin can be selected, according to the setting of the C/\bar{A} bit in SMR and the CKE1 and CKE0 bits in SCR. For details on SCI clock source selection, see table 15.9.

When the SCI is operated on an internal clock, the serial clock is output from the SCK pin.

Eight serial clock pulses are output in the transfer of one character, and when no transfer is performed the clock is fixed high. When only receive operations are performed, however, the serial clock is output until an overrun error occurs or the RE bit is cleared to 0. To perform receive operations in units of one character, select an external clock as the clock source.

Data Transfer Operations

SCI Initialization (Synchronous Mode): Before transmitting and receiving data, first clear the TE and RE bits in SCR to 0, then initialize the SCI as described below.

When the operating mode, transfer format, etc., is changed, the TE and RE bits must be cleared to 0 before making the change using the following procedure. When the TE bit is cleared to 0, the TDRE flag is set to 1 and TSR is initialized. Note that clearing the RE bit to 0 does not change the settings of the RDRF, PER, FER, and ORER flags, or the contents of RDR.

Figure 15.15 shows a sample SCI initialization flowchart.

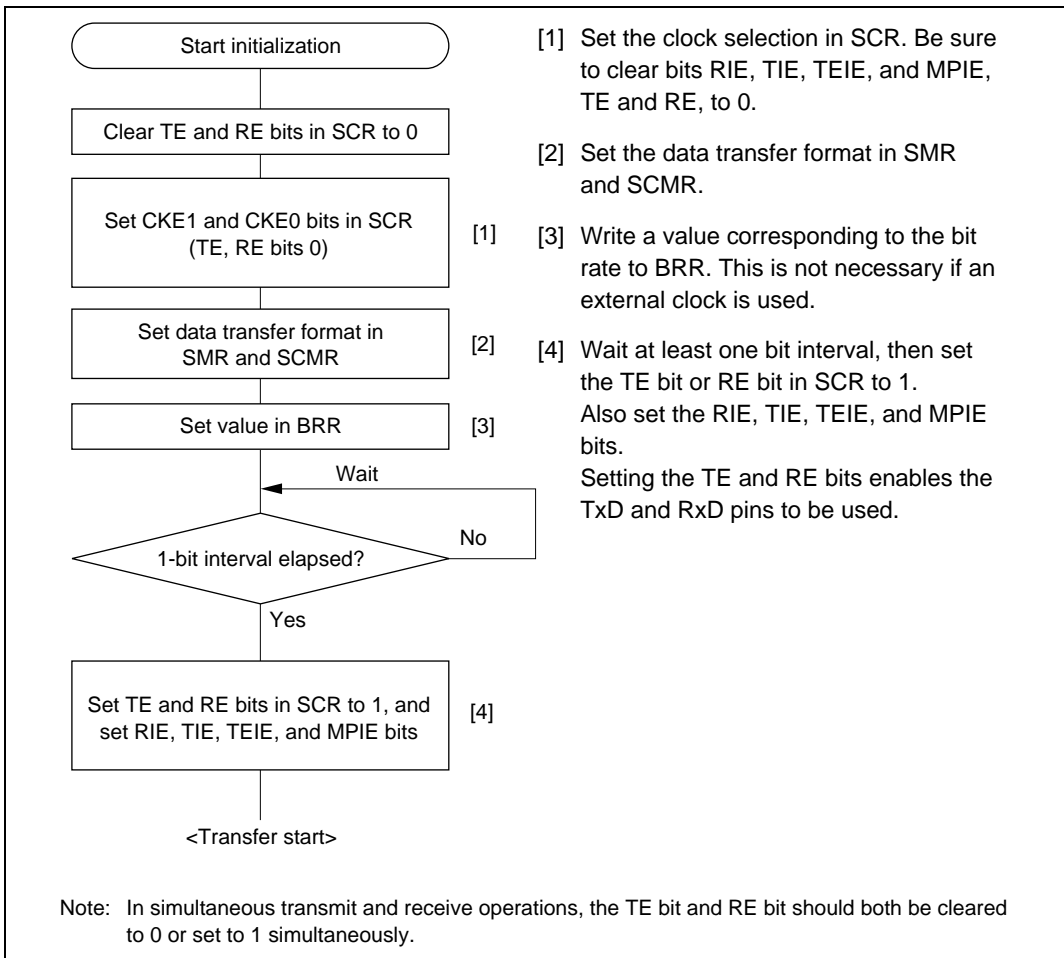


Figure 15.15 Sample SCI Initialization Flowchart

Serial Data Transmission (Synchronous Mode): Figure 15.16 shows a sample flowchart for serial transmission.

The following procedure should be used for serial data transmission.

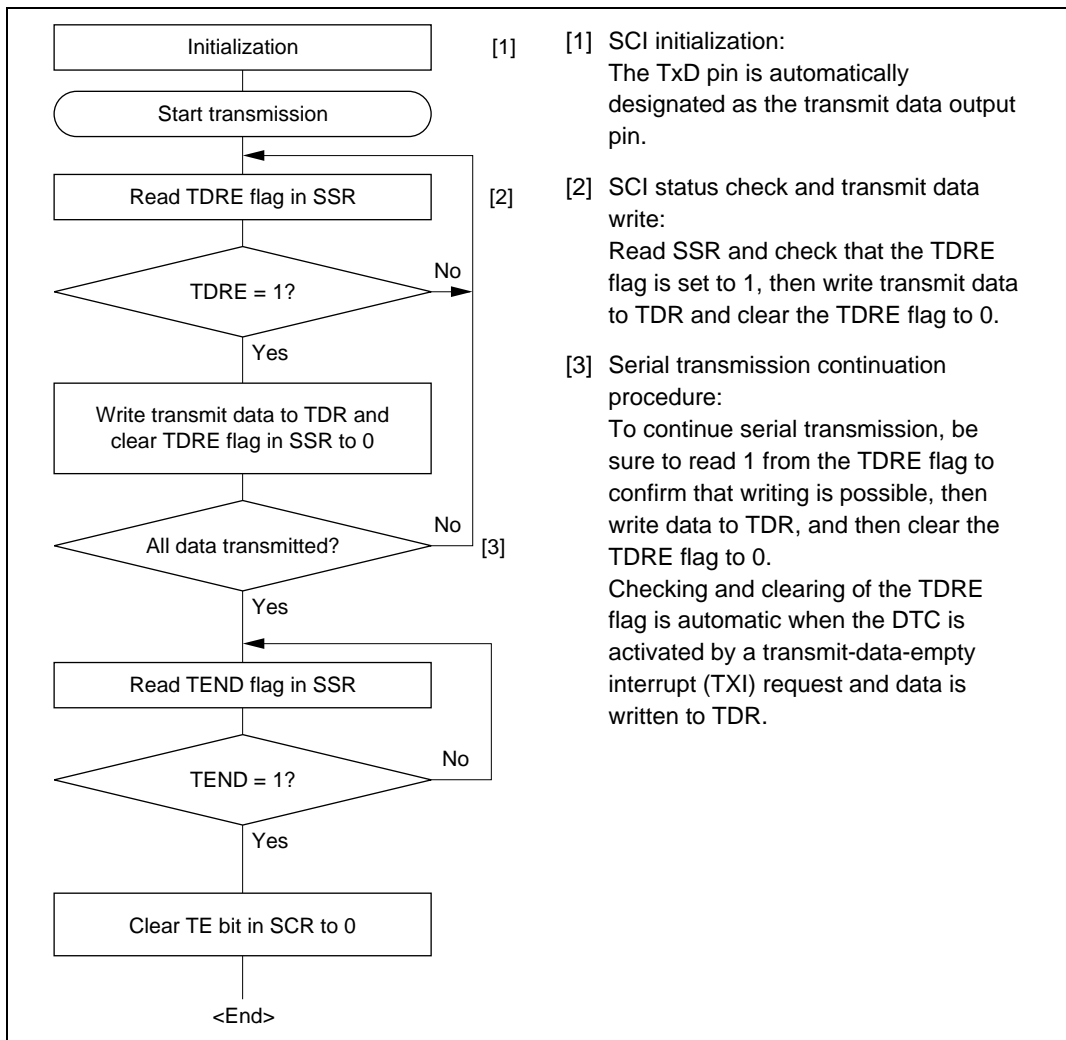


Figure 15.16 Sample Serial Transmission Flowchart

In serial transmission, the SCI operates as described below.

1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission. If the TIE bit is set to 1 at this time, a transmit-data-empty interrupt (TXI) is generated.
When clock output mode has been set, the SCI outputs 8 serial clock pulses. When use of an external clock has been specified, data is output synchronized with the input clock.
The serial transmit data is sent from the TxD pin starting with the LSB (bit 0) and ending with the MSB (bit 7).
3. The SCI checks the TDRE flag at the timing for sending the MSB (bit 7).
If the TDRE flag is cleared to 0, data is transferred from TDR to TSR, and serial transmission of the next frame is started.
If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, the MSB (bit 7) is sent, and the TxD pin maintains its state.
If the TEIE bit in SCR is set to 1 at this time, a transmit-end interrupt (TEI) request is generated.
4. After completion of serial transmission, the SCK pin is held in a constant state.

Figure 15.17 shows an example of SCI operation in transmission.

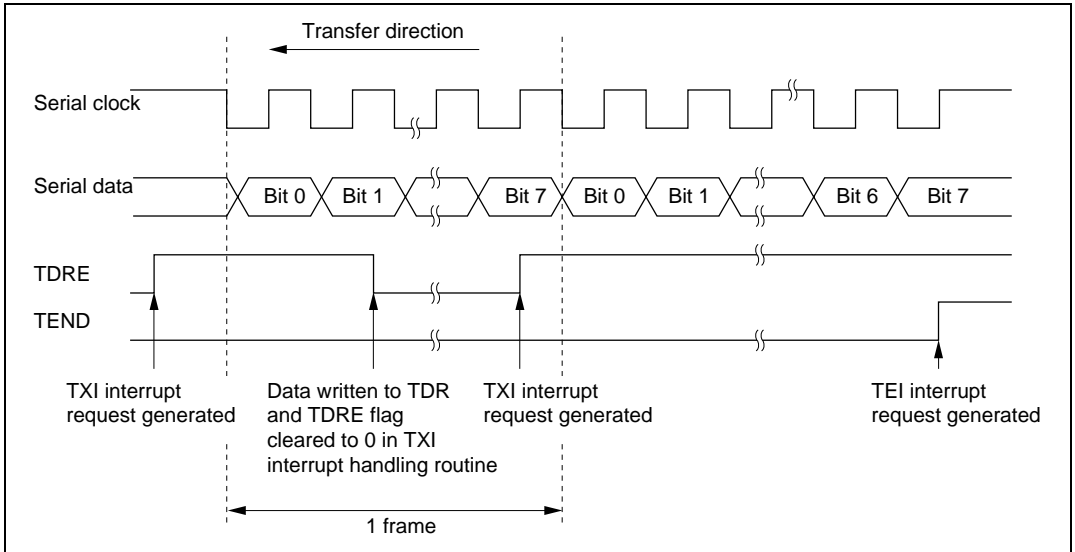


Figure 15.17 Example of SCI Operation in Transmission

Serial Data Reception (Synchronous Mode): Figure 15.18 shows a sample flowchart for serial reception.

The following procedure should be used for serial data reception.

When changing the operating mode from asynchronous to synchronous, be sure to check that the ORER, PER, and FER flags are all cleared to 0.

The RDRF flag will not be set if the FER or PER flag is set to 1, and neither transmit nor receive operations will be possible.

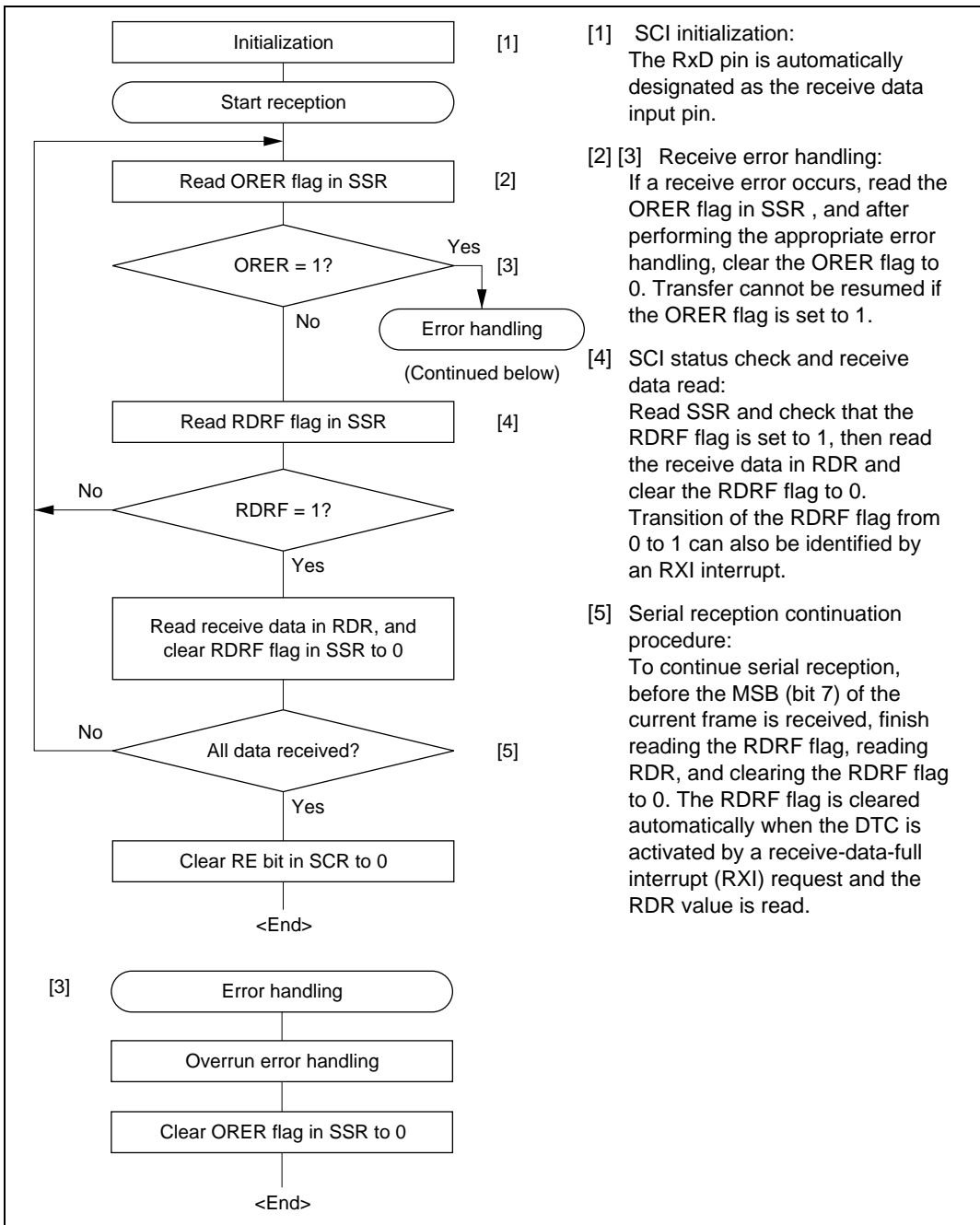


Figure 15.18 Sample Serial Reception Flowchart

In serial reception, the SCI operates as described below.

1. The SCI performs internal initialization in synchronization with serial clock input or output.
2. The received data is stored in RSR in LSB-to-MSB order.
After reception, the SCI checks whether the RDRF flag is 0 and the receive data can be transferred from RSR to RDR.
If this check is passed, the RDRF flag is set to 1, and the receive data is stored in RDR. If a receive error is detected in the error check, the operation is as shown in table 15.11.
Neither transmit nor receive operations can be performed subsequently when a receive error has been found in the error check.
3. If the RIE bit in SCR is set to 1 when the RDRF flag changes to 1, a receive-data-full interrupt (RXI) request is generated.
Also, if the RIE bit in SCR is set to 1 when the ORER flag changes to 1, a receive-error interrupt (ERI) request is generated.

Figure 15.19 shows an example of SCI operation in reception.

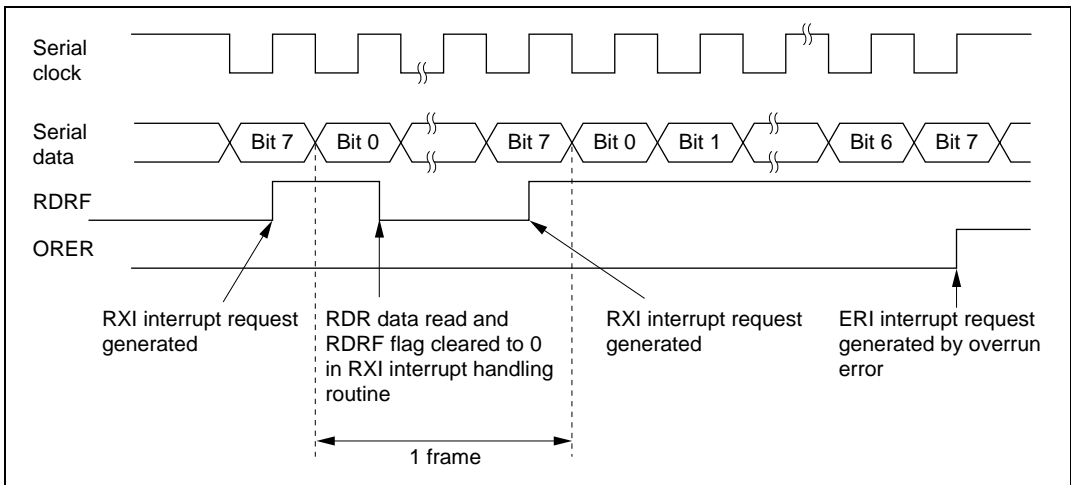


Figure 15.19 Example of SCI Operation in Reception

Simultaneous Serial Data Transmission and Reception (Synchronous Mode): Figure 15.20 shows a sample flowchart for simultaneous serial transmit and receive operations.

The following procedure should be used for simultaneous serial data transmit and receive operations.

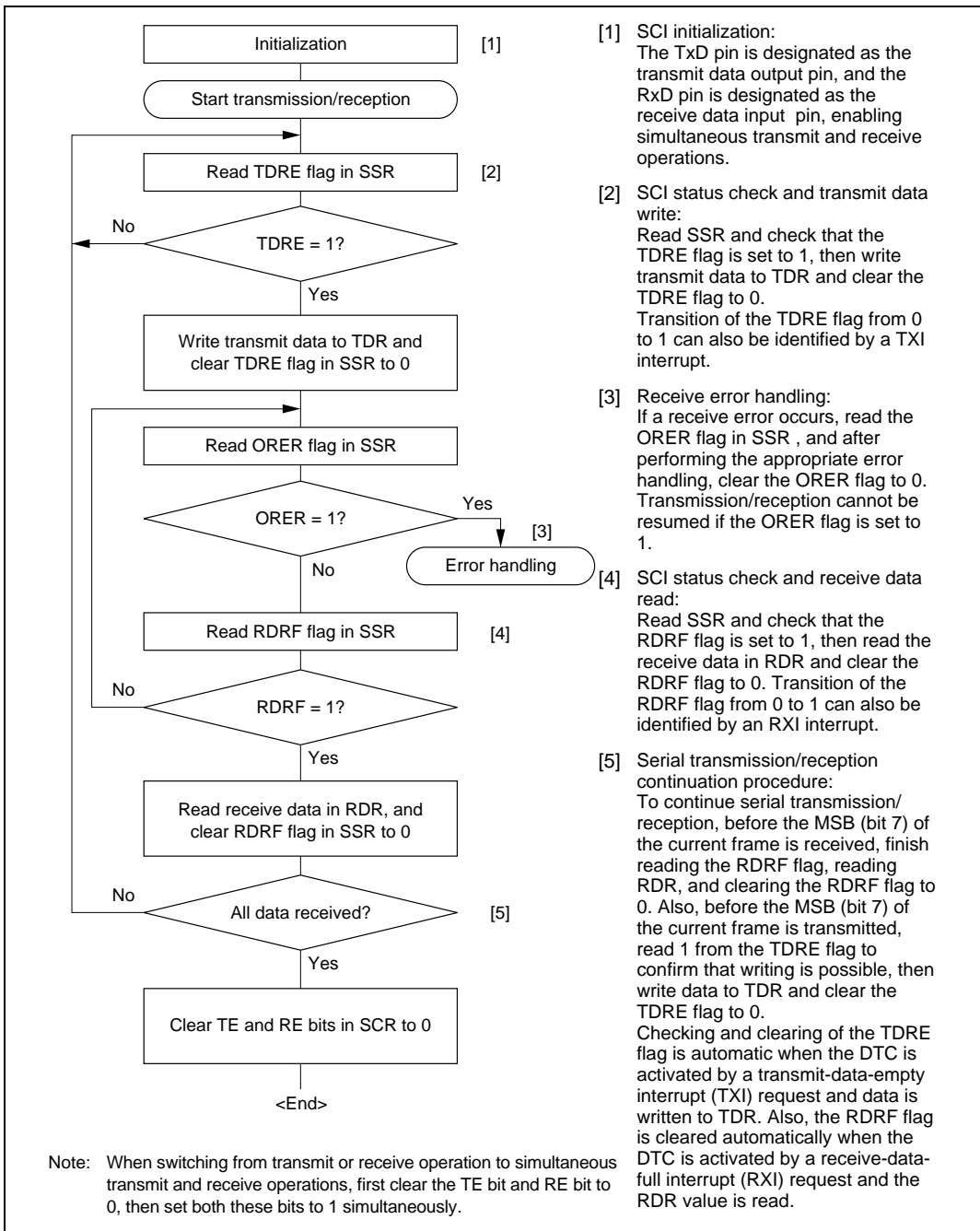


Figure 15.20 Sample Flowchart of Simultaneous Serial Transmit and Receive Operations

15.3.5 IrDA Operation

Figure 15.21 shows a block diagram of the IrDA function.

When the IrDA function is enabled with bit IrE in KBCOMP, the SCI channel 2 TxD2 and RxD2 signals are subjected to waveform encoding/decoding conforming to IrDA specification version 1.0 (IrTxD and IrRxD pins). By connecting these pins to an infrared transceiver/receiver, it is possible to implement infrared transmission/reception conforming to the IrDA specification version 1.0 system.

In the IrDA specification version 1.0 system, communication is started at a transfer rate of 9600 bps, and subsequently the transfer rate can be varied as necessary. As the IrDA interface in the H8S/2138 Group and H8S/2134 Group does not include a function for varying the transfer rate automatically, the transfer rate setting must be changed by software.

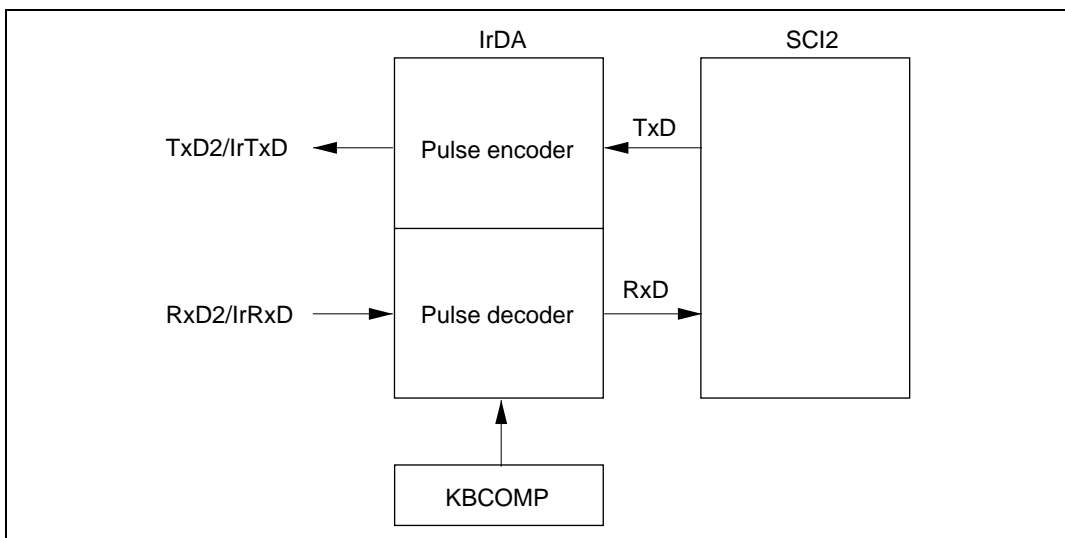


Figure 15.21 Block Diagram of IrDA Function

Transmission: In transmission, the output signal (UART frame) from the SCI is converted to an IR frame by the IrDA interface (see figure 15.22).

When the serial data is 0, a high-level pulses of $3/16$ the bit rate (interval equivalent to the width of one bit) is output (initial value). The high-level pulse can be varied according to the setting of bits IrCKS2 to IrCKS0 in KBCOMP.

The high-level pulse width is fixed at a minimum of $1.41 \mu\text{s}$, and a maximum of $(3/16 + 2.5\%) \times$ bit rate or $(3/16 \times \text{bit rate}) + 1.08 \mu\text{s}$. When system clock ϕ is 20 MHz, $1.6 \mu\text{s}$ can be set as the minimum high-level pulse width at $1.41 \mu\text{s}$ or above.

When the serial data is 1, no pulse is output.

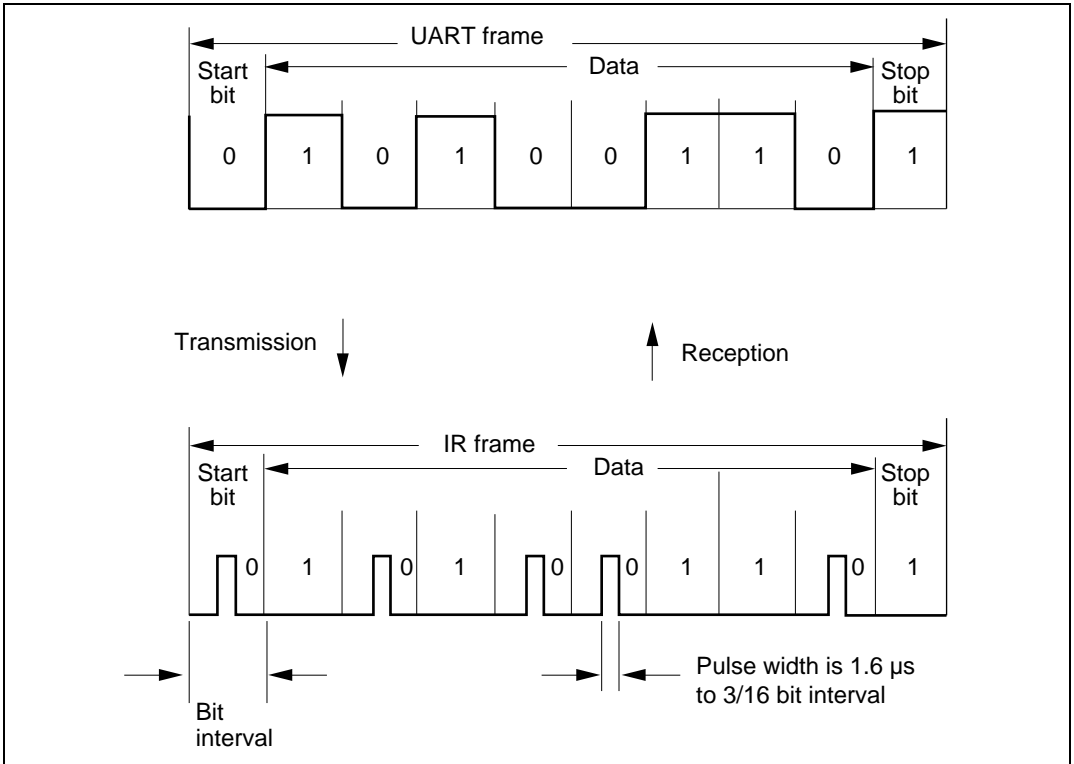


Figure 15.22 IrDA Transmit/Receive Operations

Reception: In reception, IR frame data is converted to a UART frame by the IrDA interface, and input to the SCI.

When a high-level pulse is detected, 0 data is output, and if there is no pulse during a one-bit interval, 1 data is output. Note that a pulse shorter than the minimum pulse width of $1.41 \mu\text{s}$ will be identified as a 0 signal.

High-Level Pulse Width Selection: Table 15.12 shows possible settings for bits IrCKS2 to IrCKS0 (minimum pulse width), and H8S/2138 Group and H8S/2134 Group operating frequencies and bit rates, for making the pulse width shorter than $3/16$ times the bit rate in transmission.

Table 15.12 Bit IrCKS2 to IrCKS0 Settings

| Operating Frequency ϕ (MHz) | Bit Rate (bps) (Upper Row) / Bit Interval \times 3/16 (μ s) (Lower Row) | | | | | |
|-------------------------------------|--|-------|-------|-------|-------|--------|
| | 2400 | 9600 | 19200 | 38400 | 57600 | 115200 |
| | 78.13 | 19.53 | 9.77 | 4.88 | 3.26 | 1.63 |
| 2 | 010 | 010 | 010 | 010 | 010 | — |
| 2.097152 | 010 | 010 | 010 | 010 | 010 | — |
| 2.4576 | 010 | 010 | 010 | 010 | 010 | — |
| 3 | 011 | 011 | 011 | 011 | 011 | — |
| 3.6864 | 011 | 011 | 011 | 011 | 011 | 011 |
| 4.9152 | 011 | 011 | 011 | 011 | 011 | 011 |
| 5 | 011 | 011 | 011 | 011 | 011 | 011 |
| 6 | 100 | 100 | 100 | 100 | 100 | 100 |
| 6.144 | 100 | 100 | 100 | 100 | 100 | 100 |
| 7.3728 | 100 | 100 | 100 | 100 | 100 | 100 |
| 8 | 100 | 100 | 100 | 100 | 100 | 100 |
| 9.8304 | 100 | 100 | 100 | 100 | 100 | 100 |
| 10 | 100 | 100 | 100 | 100 | 100 | 100 |
| 12 | 101 | 101 | 101 | 101 | 101 | 101 |
| 12.288 | 101 | 101 | 101 | 101 | 101 | 101 |
| 14 | 101 | 101 | 101 | 101 | 101 | 101 |
| 14.7456 | 101 | 101 | 101 | 101 | 101 | 101 |
| 16 | 101 | 101 | 101 | 101 | 101 | 101 |
| 16.9344 | 101 | 101 | 101 | 101 | 101 | 101 |
| 17.2032 | 101 | 101 | 101 | 101 | 101 | 101 |
| 18 | 101 | 101 | 101 | 101 | 101 | 101 |
| 19.6608 | 101 | 101 | 101 | 101 | 101 | 101 |
| 20 | 101 | 101 | 101 | 101 | 101 | 101 |

Legend:

—: An SCI bit rate setting cannot be mode.

15.4 SCI Interrupts

The SCI has four interrupt sources: the transmit-end interrupt (TEI) request, receive-error interrupt (ERI) request, receive-data-full interrupt (RXI) request, and transmit-data-empty interrupt (TXI) request. Table 15.13 shows the interrupt sources and their relative priorities. Individual interrupt sources can be enabled or disabled with the TIE, RIE, and TEIE bits in SCR. Each kind of interrupt request is sent to the interrupt controller independently.

When the TDRE flag in SSR is set to 1, a TXI interrupt request is generated. When the TEND flag in SSR is set to 1, a TEI interrupt request is generated. A TXI interrupt can activate the DTC to perform data transfer. The TDRE flag is cleared to 0 automatically when data transfer is performed by the DTC. The DTC cannot be activated by a TEI interrupt request.

When the RDRF flag in SSR is set to 1, an RXI interrupt request is generated. When the ORER, PER, or FER flag in SSR is set to 1, an ERI interrupt request is generated. An RXI interrupt can activate the DTC to perform data transfer. The RDRF flag is cleared to 0 automatically when data transfer is performed by the DTC. The DTC cannot be activated by an ERI interrupt request.

Table 15.13 SCI Interrupt Sources

| Channel | Interrupt Source | Description | DTC Activation | Priority* |
|---------|------------------|-------------------------------------|----------------|------------------|
| 0 | ERI | Receive error (ORER, FER, or PER) | Not possible | High ↑ Low |
| | RXI | Receive data register full (RDRF) | Possible | |
| | TXI | Transmit data register empty (TDRE) | Possible | |
| | TEI | Transmit end (TEND) | Not possible | |
| 1 | ERI | Receive error (ORER, PER, or FER) | Not possible | High ↑ Low |
| | RXI | Receive data register full (RDRF) | Possible | |
| | TXI | Transmit data register empty (TDRE) | Possible | |
| | TEI | Transmit end (TEND) | Not possible | |
| 2 | ERI | Receive error (ORER, PER, or FER) | Not possible | High ↑ Low |
| | RXI | Receive data register full (RDRF) | Possible | |
| | TXI | Transmit data register empty (TDRE) | Possible | |
| | TEI | Transmit end (TEND) | Not possible | |

Note: * The table shows the initial state immediately after a reset. Relative channel priorities can be changed by the interrupt controller.

The TEI interrupt is requested when the TEND flag is set to 1 while the TEIE bit is set to 1. The TEND flag is cleared at the same time as the TDRE flag. Consequently, if a TEI interrupt and a

TXI interrupt are requested simultaneously, the TXI interrupt will have priority for acceptance, and the TDRE flag and TEND flag may be cleared. Note that the TEI interrupt will not be accepted in this case.

15.5 Usage Notes

The following points should be noted when using the SCI.

Relation between Writes to TDR and the TDRE Flag

The TDRE flag in SSR is a status flag that indicates that transmit data has been transferred from TDR to TSR. When the SCI transfers data from TDR to TSR, the TDRE flag is set to 1.

Data can be written to TDR regardless of the state of the TDRE flag. However, if new data is written to TDR when the TDRE flag is cleared to 0, the data stored in TDR will be lost since it has not yet been transferred to TSR. It is therefore essential to check that the TDRE flag is set to 1 before writing transmit data to TDR.

Operation when Multiple Receive Errors Occur Simultaneously

If a number of receive errors occur at the same time, the state of the status flags in SSR is as shown in table 15.14. If there is an overrun error, data is not transferred from RSR to RDR, and the receive data is lost.

Table 15.14 State of SSR Status Flags and Transfer of Receive Data

| SSR Status Flags | | | | Receive Data Transfer | Receive Errors |
|------------------|------|-----|-----|-----------------------|--|
| RDRF | ORER | FER | PER | RSR to RDR | |
| 1 | 1 | 0 | 0 | X | Overrun error |
| 0 | 0 | 1 | 0 | O | Framing error |
| 0 | 0 | 0 | 1 | O | Parity error |
| 1 | 1 | 1 | 0 | X | Overrun error + framing error |
| 1 | 1 | 0 | 1 | X | Overrun error + parity error |
| 0 | 0 | 1 | 1 | O | Framing error + parity error |
| 1 | 1 | 1 | 1 | X | Overrun error + framing error + parity error |

Notes: O: Receive data is transferred from RSR to RDR.

X: Receive data is not transferred from RSR to RDR.

Break Detection and Processing: When a framing error (FER) is detected, a break can be detected by reading the RxD pin value directly. In a break, the input from the RxD pin becomes all 0s, and so the FER flag is set, and the parity error flag (PER) may also be set.

Note that, since the SCI continues the receive operation after receiving a break, even if the FER flag is cleared to 0, it will be set to 1 again.

Sending a Break: The TxD pin has a dual function as an I/O port whose direction (input or output) is determined by DR and DDR. This feature can be used to send a break.

Between serial transmission initialization and setting of the TE bit to 1, the mark state is replaced by the value of DR (the pin does not function as the TxD pin until the TE bit is set to 1). Consequently, DDR and DR for the port corresponding to the TxD pin should first be set to 1.

To send a break during serial transmission, first clear DR to 0, then clear the TE bit to 0.

When the TE bit is cleared to 0, the transmitter is initialized regardless of the current transmission state, the TxD pin becomes an I/O port, and 0 is output from the TxD pin.

Receive Error Flags and Transmit Operations (Synchronous Mode Only):

Transmission cannot be started when a receive error flag (ORER, PER, or FER) is set to 1, even if the TDRE flag is cleared to 0. Be sure to clear the receive error flags to 0 before starting transmission.

Note also that receive error flags cannot be cleared to 0 even if the RE bit is cleared to 0.

Receive Data Sampling Timing and Reception Margin in Asynchronous Mode:

In asynchronous mode, the SCI operates on a base clock with a frequency of 16 times the transfer rate.

In reception, the SCI samples the falling edge of the start bit using the base clock, and performs internal synchronization. Receive data is latched internally at the rising edge of the 8th pulse of the base clock. This is illustrated in figure 15.23.

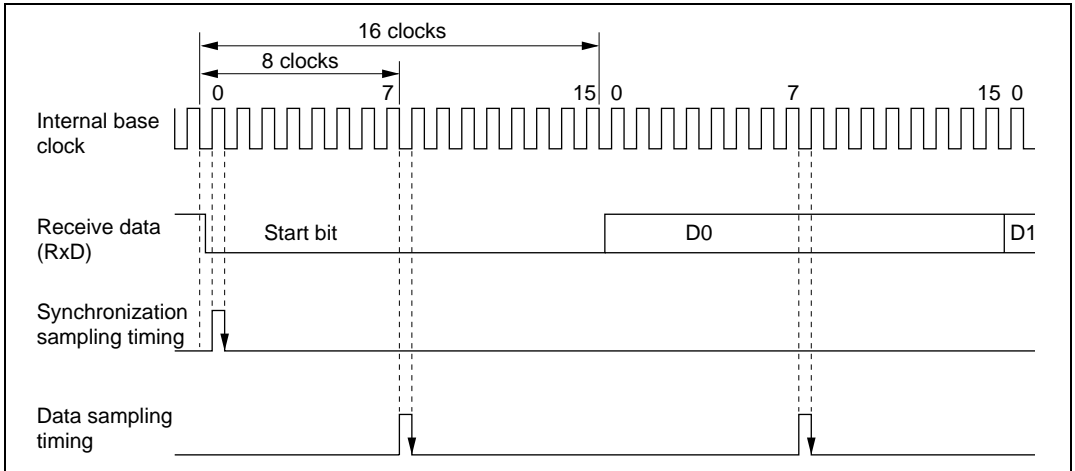


Figure 15.23 Receive Data Sampling Timing in Asynchronous Mode

Thus the receive margin in asynchronous mode is given by equation (1) below.

$$M = \left[\left(0.5 - \frac{1}{2N} \right) - (L - 0.5)F - \frac{|D - 0.5|}{N}(1 + F) \right] \times 100\% \quad \text{..... (1)}$$

Where M: Receive margin (%)

N: Ratio of bit rate to clock (N = 16)

D: Clock duty (D = 0 to 1.0)

L: Frame length (L = 9 to 12)

F: Absolute value of clock rate deviation

Assuming values of F = 0 and D = 0.5 in equation (1), a receive margin of 46.875% is given by equation (2) below.

When D = 0.5 and F = 0,

$$\begin{aligned} M &= \left(0.5 - \frac{1}{2 \times 16} \right) \times 100\% \\ &= 46.875\% \quad \text{..... (2)} \end{aligned}$$

However, this is only a theoretical value, and a margin of 20% to 30% should be allowed in system design.

Restrictions on Use of DTC

- When an external clock source is used as the serial clock, the transmit clock should not be input until at least 5 ϕ clock cycles after TDR is updated by the DTC. Misoperation may occur if the transmit clock is input within 4 clock cycles after TDR is updated. (Figure 15.24)
- When RDR is read by the DTC, be sure to set the activation source to the relevant SCI receive-data-full interrupt (RXI).

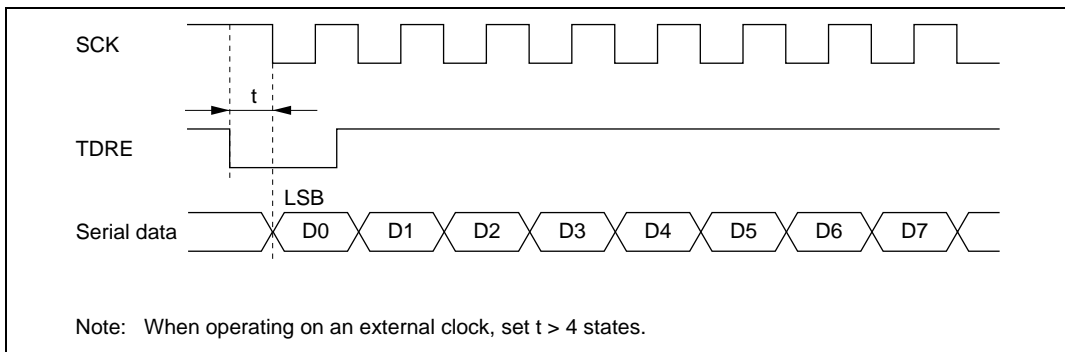


Figure 15.24 Example of Synchronous Transmission by DTC

Section 16 I²C Bus Interface [H8S/2138 Group Option]

A two-channel I²C bus interface is available as an option in the H8S/2138 Group. The I²C bus interface is not available for the H8S/2134 Group. Observe the following notes when using this option.

1. For mask-ROM versions, a W is added to the part number in products in which this optional function is used.
Examples: HD6432137SW
2. The product number is identical for F-ZTAT versions. However, be sure to inform your Renesas sales representative if you will be using this option.

16.1 Overview

A two-channel I²C bus interface is available for the H8S/2138 Group as an option. The I²C bus interface conforms to and provides a subset of the Philips I²C bus (inter-IC bus) interface functions. The register configuration that controls the I²C bus differs partly from the Philips configuration, however.

Each I²C bus interface channel uses only one data line (SDA) and one clock line (SCL) to transfer data, saving board and connector space.

16.1.1 Features

- Selection of addressing format or non-addressing format
 - I²C bus format: addressing format with acknowledge bit, for master/slave operation
 - Serial format: non-addressing format without acknowledge bit, for master operation only
- Conforms to Philips I²C bus interface (I²C bus format)
- Two ways of setting slave address (I²C bus format)
- Start and stop conditions generated automatically in master mode (I²C bus format)
- Selection of acknowledge output levels when receiving (I²C bus format)
- Automatic loading of acknowledge bit when transmitting (I²C bus format)
- Wait function in master mode (I²C bus format)

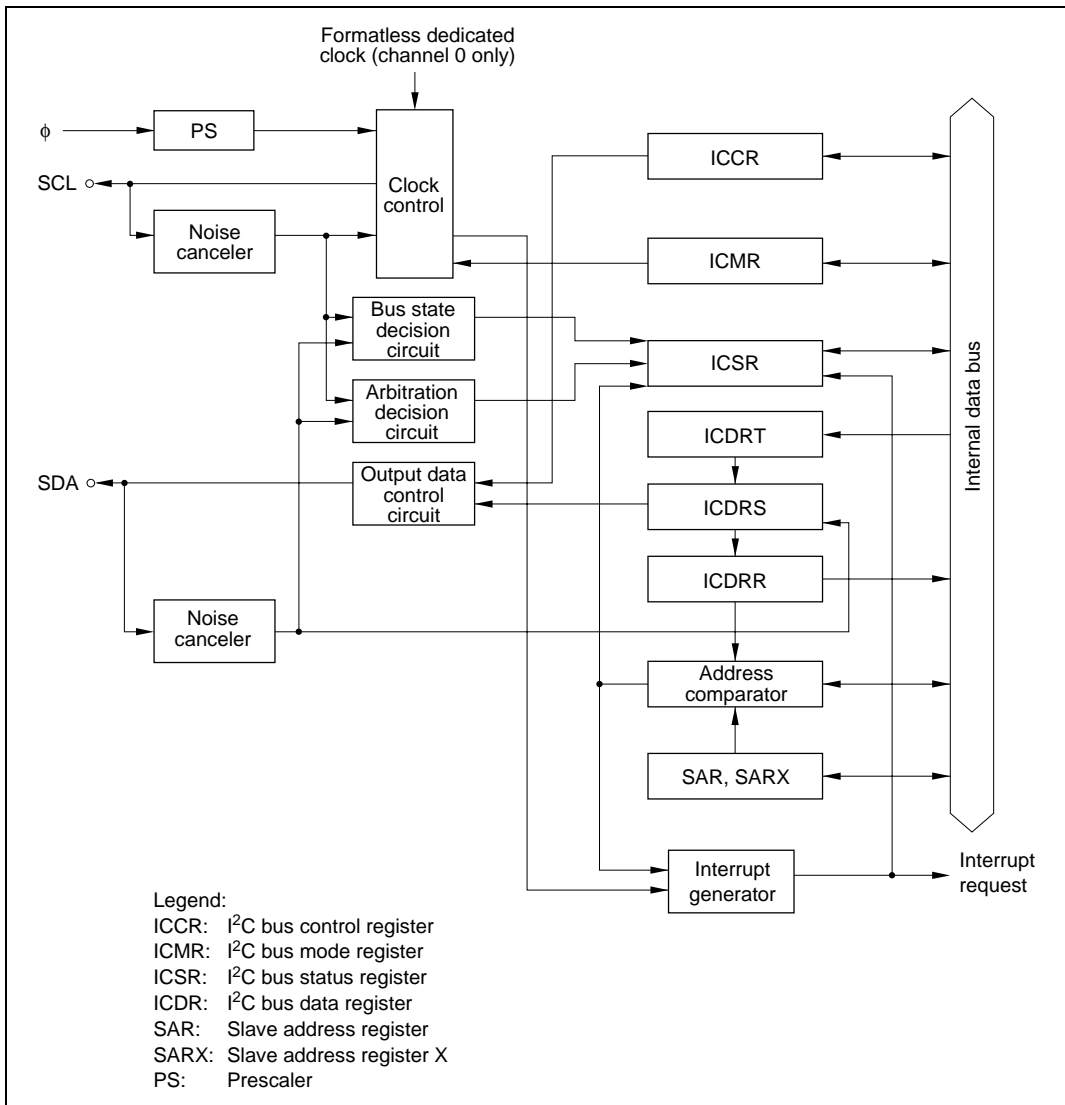
A wait can be inserted by driving the SCL pin low after data transfer, excluding acknowledgement. The wait can be cleared by clearing the interrupt flag.

- Wait function in slave mode (I²C bus format)
A wait request can be generated by driving the SCL pin low after data transfer, excluding acknowledgement. The wait request is cleared when the next transfer becomes possible.
- Three interrupt sources
 - Data transfer end (including transmission mode transition with I²C bus format and address reception after loss of master arbitration)
 - Address match: when any slave address matches or the general call address is received in slave receive mode (I²C bus format)
 - Stop condition detection
- Selection of 16 internal clocks (in master mode)
- Direct bus drive (with SCL and SDA pins)
 - Two pins—P52/SCL0 and P97/SDA0—(normally NMOS push-pull outputs) function as NMOS open-drain outputs when the bus drive function is selected.
 - Two pins—P86/SCL1 and P42/SDA1—(normally CMOS pins) function as NMOS-only outputs when the bus drive function is selected.
- Automatic switching from formatless mode to I²C bus format (channel 0 only)
 - Formatless operation (no start/stop conditions, non-addressing mode) in slave mode
 - Operation using a common data pin (SDA) and independent clock pins (VSYNCL, SCL)
 - Automatic switching from formatless mode to I²C bus format on the fall of the SCL pin

16.1.2 Block Diagram

Figure 16.1 shows a block diagram of the I²C bus interface.

Figure 16.2 shows an example of I/O pin connections to external circuits. Channel 0 I/O pins and channel 1 I/O pins differ in structure, and have different specifications for permissible applied voltages. For details, see section 25, Electrical Characteristics.

Figure 16.1 Block Diagram of I²C Bus Interface

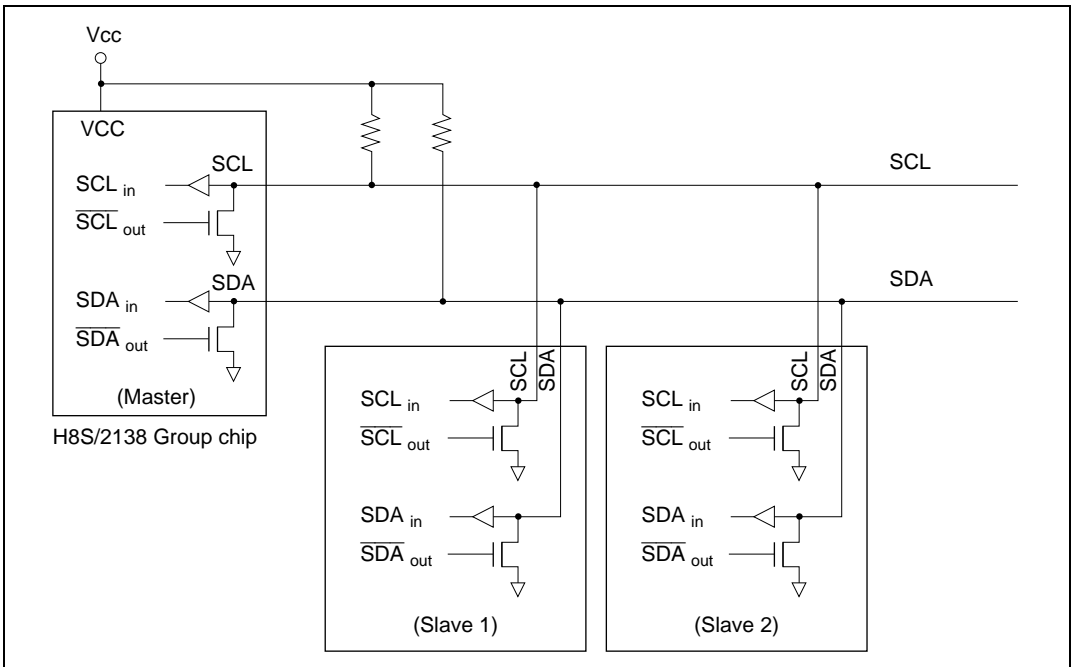


Figure 16.2 I²C Bus Interface Connections (Example: H8S/2138 Group Chip as Master)

16.1.3 Input/Output Pins

Table 16.1 summarizes the input/output pins used by the I²C bus interface.

Table 16.1 I²C Bus Interface Pins

| Channel | Name | Abbreviation* | I/O | Function |
|---------|-------------------------|---------------|-------|------------------------------------|
| 0 | Serial clock | SCL0 | I/O | IIC0 serial clock input/output |
| | Serial data | SDA0 | I/O | IIC0 serial data input/output |
| | Formatless serial clock | VSYNCl | Input | IIC0 formatless serial clock input |
| 1 | Serial clock | SCL1 | I/O | IIC1 serial clock input/output |
| | Serial data | SDA1 | I/O | IIC1 serial data input/output |

Note: * In the text, the channel subscript is omitted, and only SCL and SDA are used.

16.1.4 Register Configuration

Table 16.2 summarizes the registers of the I²C bus interface.

Table 16.2 Register Configuration

| Channel | Name | Abbreviation | R/W | Initial Value | Address* ¹ |
|---------|---------------------------------------|--------------|-----|---------------|-----------------------|
| 0 | I ² C bus control register | ICCR0 | R/W | H'01 | H'FFD8 |
| | I ² C bus status register | ICSR0 | R/W | H'00 | H'FFD9 |
| | I ² C bus data register | ICDR0 | R/W | — | H'FFDE* ² |
| | I ² C bus mode register | ICMR0 | R/W | H'00 | H'FFDF* ² |
| | Slave address register | SAR0 | R/W | H'00 | H'FFDF* ² |
| | Second slave address register | SARX0 | R/W | H'01 | H'FFDE* ² |
| 1 | I ² C bus control register | ICCR1 | R/W | H'01 | H'FF88 |
| | I ² C bus status register | ICSR1 | R/W | H'00 | H'FF89 |
| | I ² C bus data register | ICDR1 | R/W | — | H'FF8E* ² |
| | I ² C bus mode register | ICMR1 | R/W | H'00 | H'FF8F* ² |
| | Slave address register | SAR1 | R/W | H'00 | H'FF8F* ² |
| | Second slave address register | SARX1 | R/W | H'01 | H'FF8E* ² |
| Common | Serial timer control register | STCR | R/W | H'00 | H'FFC3 |
| | DDC switch register | DDCSWR | R/W | H'0F | H'FEE6 |
| | Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | | MSTPCRL | R/W | H'FF | H'FF87 |

Notes: 1. Lower 16 bits of the address.

2. The register that can be written or read depends on the ICE bit in the I²C bus control register. The slave address register can be accessed when ICE = 0, and the I²C bus mode register can be accessed when ICE = 1.

The I²C bus interface registers are assigned to the same addresses as other registers. Register selection is performed by means of the IICE bit in the serial timer control register (STCR).

16.2 Register Descriptions

16.2.1 I²C Bus Data Register (ICDR)

| | | | | | | | | |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICDR7 | ICDR6 | ICDR5 | ICDR4 | ICDR3 | ICDR2 | ICDR1 | ICDR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

- ICDRR

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICDRR7 | ICDRR6 | ICDRR5 | ICDRR4 | ICDRR3 | ICDRR2 | ICDRR1 | ICDRR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | R | R | R | R | R | R | R | R |

- ICDRS

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICDRS7 | ICDRS6 | ICDRR5 | ICDRS4 | ICDRS3 | ICDRS2 | ICDRS1 | ICDRS0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | — | — | — | — | — | — | — | — |

- ICDRT

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICDRT7 | ICDRT6 | ICDRT5 | ICDRT4 | ICDRT3 | ICDRT2 | ICDRT1 | ICDRT0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | W | W | W | W | W | W | W | W |

- TDRE, RDRF (internal flags)

| | | |
|---------------|------|------|
| Bit | — | — |
| | TDRE | RDRF |
| Initial value | 0 | 0 |
| Read/Write | — | — |

ICDR is an 8-bit readable/writable register that is used as a transmit data register when transmitting and a receive data register when receiving. ICDR is divided internally into a shift register (ICDRS), receive buffer (ICDRR), and transmit buffer (ICDRT). ICDRS cannot be read or written by the CPU, ICDRR is read-only, and ICDRT is write-only. Data transfers among the three registers are performed automatically in coordination with changes in the bus state, and affect the status of internal flags such as TDRE and RDRF.

If IIC is in transmit mode and the next data is in ICDRT (the TDRE flag is 0) following transmission/reception of one frame of data using ICDRS, data is transferred automatically from ICDRT to ICDRS. If IIC is in receive mode and no previous data remains in ICDRR (the RDRF flag is 0) following transmission/reception of one frame of data using ICDRS, data is transferred automatically from ICDRS to ICDRR.

If the number of bits in a frame, excluding the acknowledge bit, is less than 8, transmit data and receive data are stored differently. Transmit data should be written justified toward the MSB side when $MLS = 0$, and toward the LSB side when $MLS = 1$. Receive data bits read from the LSB side should be treated as valid when $MLS = 0$, and bits read from the MSB side when $MLS = 1$.

ICDR is assigned to the same address as SARX, and can be written and read only when the ICE bit is set to 1 in ICCR.

The value of ICDR is undefined after a reset.

The TDRE and RDRF flags are set and cleared under the conditions shown below. Setting the TDRE and RDRF flags affects the status of the interrupt flags.

| TDRE | Description |
|------|--|
| 0 | <p>The next transmit data is in ICDR (ICDRT), or transmission cannot be started (Initial value)</p> <p>[Clearing conditions]</p> <ul style="list-style-type: none"> • When transmit data is written in ICDR (ICDRT) in transmit mode (TRS = 1) • When a stop condition is detected in the bus line state after a stop condition is issued with the I²C bus format or serial format selected • When a stop condition is detected with the I²C bus format selected • In receive mode (TRS = 0) <p>(A 0 write to TRS during transfer is valid after reception of a frame containing an acknowledge bit)</p> |
| 1 | <p>The next transmit data can be written in ICDR (ICDRT)</p> <p>[Setting conditions]</p> <ul style="list-style-type: none"> • In transmit mode (TRS = 1), when a start condition is detected in the bus line state after a start condition is issued in master mode with the I²C bus format or serial format selected • At the first transmit mode setting (TRS = 1) (first transmit mode setting only) after the mode is switched from I²C bus mode to formatless mode. • When data is transferred from ICDRT to ICDRS (Data transfer from ICDRT to ICDRS when TRS = 1 and TDRE = 0, and ICDRS is empty) • When detecting a start condition and then switching from slave receive mode (TRS = 0) state to transmit mode (TRS = 1) (first transmit mode switching only). |
| RDRF | Description |
| 0 | <p>The data in ICDR (ICDRR) is invalid (Initial value)</p> <p>[Clearing condition]</p> <p>When ICDR (ICDRR) receive data is read in receive mode</p> |
| 1 | <p>The ICDR (ICDRR) receive data can be read</p> <p>[Setting condition]</p> <p>When data is transferred from ICDRS to ICDRR (Data transfer from ICDRS to ICDRR in case of normal termination with TRS = 0 and RDRF = 0)</p> |

16.2.2 Slave Address Register (SAR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|-----|
| | SVA6 | SVA5 | SVA4 | SVA3 | SVA2 | SVA1 | SVA0 | FS |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

SAR is an 8-bit readable/writable register that stores the slave address and selects the communication format. When the chip is in slave mode (and the addressing format is selected), if the upper 7 bits of SAR match the upper 7 bits of the first frame received after a start condition, the chip operates as the slave device specified by the master device. SAR is assigned to the same address as ICMR, and can be written and read only when the ICE bit is cleared to 0 in ICCR.

SAR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 1—Slave Address (SVA6 to SVA0): Set a unique address in bits SVA6 to SVA0, differing from the addresses of other slave devices connected to the I²C bus.

Bit 0—Format Select (FS): Used together with the FSX bit in SARX and the SW bit in DDCCSWR to select the communication format.

- I²C bus format: addressing format with acknowledge bit
- Synchronous serial format: non-addressing format without acknowledge bit, for master mode only
- Formatless mode (channel 0 only): non-addressing format with or without acknowledge bit, slave mode only, start/stop conditions not detected

The FS bit also specifies whether or not SAR slave address recognition is performed in slave mode.

| DDCSWR Bit 6 | SAR Bit 0 | SARX Bit 0 | Operating Mode | |
|-----------------|--------------|---------------|--|--|
| 0 | 0 | 0 | I ² C bus format <ul style="list-style-type: none"> SAR and SARX slave addresses recognized | |
| | | 1 | I ² C bus format (Initial value) <ul style="list-style-type: none"> SAR slave address recognized SARX slave address ignored | |
| | 1 | 0 | 0 | I ² C bus format <ul style="list-style-type: none"> SAR slave address ignored SARX slave address recognized |
| | | | 1 | Synchronous serial format <ul style="list-style-type: none"> SAR and SARX slave addresses ignored |
| | | 0 | 0 | Formatless mode (start/stop conditions not detected) <ul style="list-style-type: none"> Acknowledge bit used |
| | 1 | 1 | 0 | Formatless mode* (start/stop conditions not detected) <ul style="list-style-type: none"> No acknowledge bit |
| 1 | | | | |

Note: * Do not set this mode when automatic switching to the I²C bus format is performed by means of the DDCSWR setting.

16.2.3 Second Slave Address Register (SARX)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-----|
| | SVAX6 | SVAX5 | SVAX4 | SVAX3 | SVAX2 | SVAX1 | SVAX0 | FSX |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

SARX is an 8-bit readable/writable register that stores the second slave address and selects the communication format. When the chip is in slave mode (and the addressing format is selected), if the upper 7 bits of SARX match the upper 7 bits of the first frame received after a start condition, the chip operates as the slave device specified by the master device. SARX is assigned to the same address as ICDR, and can be written and read only when the ICE bit is cleared to 0 in ICCR.

SARX is initialized to H'01 by a reset and in hardware standby mode.

Bits 7 to 1—Second Slave Address (SVAX6 to SVAX0): Set a unique address in bits SVAX6 to SVAX0, differing from the addresses of other slave devices connected to the I²C bus.

Bit 0—Format Select X (FSX): Used together with the FS bit in SAR and the SW bit in DDCSR to select the communication format.

- I²C bus format: addressing format with acknowledge bit
- Synchronous serial format: non-addressing format without acknowledge bit, for master mode only
- Formatless mode: non-addressing format with or without acknowledge bit, slave mode only, start/stop conditions not detected

The FSX bit also specifies whether or not SARX slave address recognition is performed in slave mode. For details, see the description of the FS bit in SAR.

16.2.4 I²C Bus Mode Register (ICMR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|------|------|------|------|-----|-----|-----|
| | MLS | WAIT | CKS2 | CKS1 | CKS0 | BC2 | BC1 | BC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

ICMR is an 8-bit readable/writable register that selects whether the MSB or LSB is transferred first, performs master mode wait control, and selects the master mode transfer clock frequency and the transfer bit count. ICMR is assigned to the same address as SAR. ICMR can be written and read only when the ICE bit is set to 1 in ICCR.

ICMR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—MSB-First/LSB-First Select (MLS): Selects whether data is transferred MSB-first or LSB-first.

If the number of bits in a frame, excluding the acknowledge bit, is less than 8, transmit data and receive data are stored differently. Transmit data should be written justified toward the MSB side when MLS = 0, and toward the LSB side when MLS = 1. Receive data bits read from the LSB side should be treated as valid when MLS = 0, and bits read from the MSB side when MLS = 1.

Do not set this bit to 1 when the I²C bus format is used.

Bit 7

| MLS | Description | |
|------------|--------------------|-----------------|
| 0 | MSB-first | (Initial value) |
| 1 | LSB-first | |

Bit 6—Wait Insertion Bit (WAIT): Selects whether to insert a wait between the transfer of data and the acknowledge bit, in master mode with the I²C bus format. When WAIT is set to 1, after the fall of the clock for the final data bit, the IRIC flag is set to 1 in ICCR, and a wait state begins (with SCL at the low level). When the IRIC flag is cleared to 0 in ICCR, the wait ends and the acknowledge bit is transferred. If WAIT is cleared to 0, data and acknowledge bits are transferred consecutively with no wait inserted.

The IRIC flag in ICCR is set to 1 on completion of the acknowledge bit transfer, regardless of the WAIT setting.

The setting of this bit is invalid in slave mode.

Bit 6

| WAIT | Description | |
|-------------|---|-----------------|
| 0 | Data and acknowledge bits transferred consecutively | (Initial value) |
| 1 | Wait inserted between data and acknowledge bits | |

Bits 5 to 3—Serial Clock Select (CKS2 to CKS0): These bits, together with the IICX1 (channel 1) or IICX0 (channel 0) bit in the STCR register, select the serial clock frequency in master mode. They should be set according to the required transfer rate.

STCR

| IICX | STCR | | | Clock | Transfer Rate | | | | |
|------|------------|-------|-------|------------|---------------|-------------------|-------------------|--------------------|--------------------|
| | Bit 5 or 6 | Bit 5 | Bit 4 | | Bit 3 | $\phi =$ 5 MHz | $\phi =$ 8 MHz | $\phi =$ 10 MHz | $\phi =$ 16 MHz |
| 0 | 0 | 0 | 0 | $\phi/28$ | 179 kHz | 286 kHz | 357 kHz | 571 kHz* | 714 kHz* |
| | | | 1 | $\phi/40$ | 125 kHz | 200 kHz | 250 kHz | 400 kHz | 500 kHz* |
| | | 1 | 0 | $\phi/48$ | 104 kHz | 167 kHz | 208 kHz | 333 kHz | 417 kHz* |
| | | | 1 | $\phi/64$ | 78.1 kHz | 125 kHz | 156 kHz | 250 kHz | 313 kHz |
| | 1 | 0 | 0 | $\phi/80$ | 62.5 kHz | 100 kHz | 125 kHz | 200 kHz | 250 kHz |
| | | | 1 | $\phi/100$ | 50.0 kHz | 80.0 kHz | 100 kHz | 160 kHz | 200 kHz |
| | | 1 | 0 | $\phi/112$ | 44.6 kHz | 71.4 kHz | 89.3 kHz | 143 kHz | 179 kHz |
| | | | 1 | $\phi/128$ | 39.1 kHz | 62.5 kHz | 78.1 kHz | 125 kHz | 156 kHz |
| 1 | 0 | 0 | 0 | $\phi/56$ | 89.3 kHz | 143 kHz | 179 kHz | 286 kHz | 357 kHz |
| | | | 1 | $\phi/80$ | 62.5 kHz | 100 kHz | 125 kHz | 200 kHz | 250 kHz |
| | | 1 | 0 | $\phi/96$ | 52.1 kHz | 83.3 kHz | 104 kHz | 167 kHz | 208 kHz |
| | | | 1 | $\phi/128$ | 39.1 kHz | 62.5 kHz | 78.1 kHz | 125 kHz | 156 kHz |
| | 1 | 0 | 0 | $\phi/160$ | 31.3 kHz | 50.0 kHz | 62.5 kHz | 100 kHz | 125 kHz |
| | | | 1 | $\phi/200$ | 25.0 kHz | 40.0 kHz | 50.0 kHz | 80.0 kHz | 100 kHz |
| | | 1 | 0 | $\phi/224$ | 22.3 kHz | 35.7 kHz | 44.6 kHz | 71.4 kHz | 89.3 kHz |
| | | | 1 | $\phi/256$ | 19.5 kHz | 31.3 kHz | 39.1 kHz | 62.5 kHz | 78.1 kHz |

Note: * Outside the I²C bus interface specification range (normal mode: max. 100 kHz; high-speed mode: max. 400 kHz).

Bits 2 to 0—Bit Counter (BC2 to BC0): Bits BC2 to BC0 specify the number of bits to be transferred next. With the I²C bus format (when the FS bit in SAR or the FSX bit in SARX is 0), the data is transferred with one additional acknowledge bit. Bit BC2 to BC0 settings should be made during an interval between transfer frames. If bits BC2 to BC0 are set to a value other than 000, the setting should be made while the SCL line is low.

The bit counter is initialized to 000 by a reset and when a start condition is detected. The value returns to 000 at the end of a data transfer, including the acknowledge bit.

| Bit 2 | Bit 1 | Bit 0 | Bits/Frame | |
|-------|-------|-------|---------------------------|-----------------------------|
| BC2 | BC1 | BC0 | Synchronous Serial Format | I ² C Bus Format |
| 0 | 0 | 0 | 8 | 9 (Initial value) |
| | | 1 | 1 | 2 |
| | 1 | 0 | 2 | 3 |
| | | 1 | 3 | 4 |
| 1 | 0 | 0 | 4 | 5 |
| | | 1 | 5 | 6 |
| | 1 | 0 | 6 | 7 |
| | | 1 | 7 | 8 |

16.2.5 I²C Bus Control Register (ICCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|------|-----|-----|------|------|--------|-----|
| | ICE | IEIC | MST | TRS | ACKE | BBSY | IRIC | SCP |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/(W)* | W |

Note: * Only 0 can be written, to clear the flag.

ICCR is an 8-bit readable/writable register that enables or disables the I²C bus interface, enables or disables interrupts, selects master or slave mode and transmission or reception, enables or disables acknowledgement, confirms the I²C bus interface bus status, issues start/stop conditions, and performs interrupt flag confirmation.

ICCR is initialized to H'01 by a reset and in hardware standby mode.

Bit 7—I²C Bus Interface Enable (ICE): Selects whether or not the I²C bus interface is to be used. When ICE is set to 1, port pins function as SCL and SDA input/output pins and transfer operations are enabled. When ICE is cleared to 0, the I²C bus interface module is disabled and the internal state is cleared.

The SAR and SARX registers can be accessed when ICE is 0. The ICMR and ICDR registers can be accessed when ICE is 1.

Bit 7

| ICE | Description |
|------------|--|
| 0 | I ² C bus interface module disabled, with SCL and SDA signal pins set to port function (Initial value) Internal state initialization of I ² C bus interface module SAR and SARX can be accessed |
| 1 | I ² C bus interface module enabled for transfer operations (pins SCL and SCA are driving the bus) ICMR and ICDR can be accessed |

Bit 6—I²C Bus Interface Interrupt Enable (IEIC): Enables or disables interrupts from the I²C bus interface to the CPU.

Bit 6

| IEIC | Description |
|-------------|-------------------------------------|
| 0 | Interrupts disabled (Initial value) |
| 1 | Interrupts enabled |

Bit 5—Master/Slave Select (MST)**Bit 4—Transmit/Receive Select (TRS)**

MST selects whether the I²C bus interface operates in master mode or slave mode.

TRS selects whether the I²C bus interface operates in transmit mode or receive mode.

In master mode with the I²C bus format, when arbitration is lost, MST and TRS are both reset by hardware, causing a transition to slave receive mode. In slave receive mode with the addressing format (FS = 0 or FSX = 0), hardware automatically selects transmit or receive mode according to the R/ \bar{W} bit in the first frame after a start condition.

Modification of the TRS bit during transfer is deferred until transfer of the frame containing the acknowledge bit is completed, and the changeover is made after completion of the transfer.

MST and TRS select the operating mode as follows.

| Bit 5 | | Bit 4 | |
|--------------|------------|-----------------------|-----------------|
| MST | TRS | Operating Mode | |
| 0 | 0 | Slave receive mode | (Initial value) |
| | 1 | Slave transmit mode | |
| 1 | 0 | Master receive mode | |
| | 1 | Master transmit mode | |

| Bit 5 | |
|--------------|---|
| MST | Description |
| 0 | Slave mode [Clearing conditions] <ol style="list-style-type: none"> When 0 is written by software When bus arbitration is lost after transmission is started in I²C bus format master mode |
| 1 | Master mode [Setting conditions] <ol style="list-style-type: none"> When 1 is written by software (in cases other than clearing condition 2) When 1 is written in MST after reading MST = 0 (in case of clearing condition 2) |

| Bit 4 | |
|--------------|--|
| TRS | Description |
| 0 | Receive mode [Clearing conditions] <ol style="list-style-type: none"> When 0 is written by software (in cases other than setting condition 3) When 0 is written in TRS after reading TRS = 1 (in case of clearing condition 3) When bus arbitration is lost after transmission is started in I²C bus format master mode When the SW bit in DDCSWR changes from 1 to 0 |
| 1 | Transmit mode [Setting conditions] <ol style="list-style-type: none"> When 1 is written by software (in cases other than clearing conditions 3 and 4) When 1 is written in TRS after reading TRS = 0 (in case of clearing conditions 3 and 4) When a 1 is received as the R/W bit of the first frame in I²C bus format slave mode |

Bit 3—Acknowledge Bit Judgement Selection (ACKE): Specifies whether the value of the acknowledge bit returned from the receiving device when using the I²C bus format is to be ignored and continuous transfer is performed, or transfer is to be aborted and error handling, etc., performed if the acknowledge bit is 1. When the ACKE bit is 0, the value of the received acknowledge bit is not indicated by the ACKB bit, which is always 0.

In the H8S/2138 Group, the DTC can be used to perform continuous transfer. The DTC is activated when the IRTR interrupt flag is set to 1 (IRTR is one of two interrupt flags, the other being IRIC). When the ACKE bit is 0, the TDRE, IRIC, and IRTR flags are set on completion of data transmission, regardless of the value of the acknowledge bit. When the ACKE bit is 1, the TDRE, IRIC, and IRTR flags are set on completion of data transmission when the acknowledge bit is 0, and the IRIC flag alone is set on completion of data transmission when the acknowledge bit is 1.

When the DTC is activated, the TDRE, IRIC, and IRTR flags are cleared to 0 after the specified number of data transfers have been executed. Consequently, interrupts are not generated during continuous data transfer, but if data transmission is completed with a 1 acknowledge bit when the ACKE bit is set to 1, the DTC is not activated and an interrupt is generated, if enabled.

Depending on the receiving device, the acknowledge bit may be significant, in indicating completion of processing of the received data, for instance, or may be fixed at 1 and have no significance.

Bit 3

| ACKE | Description |
|------|---|
| 0 | The value of the acknowledge bit is ignored, and continuous transfer is performed (Initial value) |
| 1 | If the acknowledge bit is 1, continuous transfer is interrupted |

Bit 2—Bus Busy (BBSY): The BBSY flag can be read to check whether the I²C bus (SCL, SDA) is busy or free. In master mode, this bit is also used to issue start and stop conditions.

A high-to-low transition of SDA while SCL is high is recognized as a start condition, setting BBSY to 1. A low-to-high transition of SDA while SCL is high is recognized as a stop condition, clearing BBSY to 0.

To issue a start condition, use a MOV instruction to write 1 in BBSY and 0 in SCP. A retransmit start condition is issued in the same way. To issue a stop condition, use a MOV instruction to write 0 in BBSY and 0 in SCP. It is not possible to write to BBSY in slave mode; the I²C bus interface must be set to master transmit mode before issuing a start condition. MST and TRS should both be set to 1 before writing 1 in BBSY and 0 in SCP.

Bit 2

| BBSY | Description |
|------|---|
| 0 | Bus is free [Clearing condition] When a stop condition is detected (Initial value) |
| 1 | Bus is busy [Setting condition] When a start condition is detected |

Bit 1—I²C Bus Interface Interrupt Request Flag (IRIC): Indicates that the I²C bus interface has issued an interrupt request to the CPU. IRIC is set to 1 at the end of a data transfer, when a slave address or general call address is detected in slave receive mode, when bus arbitration is lost in master transmit mode, and when a stop condition is detected. IRIC is set at different times depending on the FS bit in SAR and the WAIT bit in ICMR. See section 16.3.6, IRIC Setting Timing and SCL Control. The conditions under which IRIC is set also differ depending on the setting of the ACKE bit in ICCR.

IRIC is cleared by reading IRIC after it has been set to 1, then writing 0 in IRIC.

When the DTC is used, IRIC is cleared automatically and transfer can be performed continuously without CPU intervention.

Bit 1

| IRIC | Description |
|------|--|
| 0 | Waiting for transfer, or transfer in progress (Initial value) [Clearing conditions] <ol style="list-style-type: none"> 1. When 0 is written in IRIC after reading IRIC = 1 2. When ICDR is written or read by the DTC (When the TDRE or RDRF flag is cleared to 0) (This is not always a clearing condition; see the description of DTC operation for details) |
| 1 | Interrupt requested [Setting conditions] <ul style="list-style-type: none"> • I²C bus format master mode <ol style="list-style-type: none"> 1. When a start condition is detected in the bus line state after a start condition is issued (when the TDRE flag is set to 1 because of first frame transmission) 2. When a wait is inserted between the data and acknowledge bit when WAIT = 1 3. At the end of data transfer (when a wait is not inserted (WAIT=0), at the rise of the 9th transmit/receive clock pulse, or when a wait is inserted (WAIT=1), at the fall of the 8th transmit/receive clock pulse) 4. When a slave address is received after bus arbitration is lost (when the AL flag is set to 1) 5. When 1 is received as the acknowledge bit when the ACKE bit is 1 (when the ACKB bit is set to 1) • I²C bus format slave mode <ol style="list-style-type: none"> 1. When the slave address (SVA, SVAX) matches (when the AAS and AASX flags are set to 1) and at the end of data transfer up to the subsequent retransmission start condition or stop condition detection (when the TDRE or RDRF flag is set to 1) 2. When the general call address is detected (when FS = 0 and the ADZ flag is set to 1) and at the end of data transfer up to the subsequent retransmission start condition or stop condition detection (when the TDRE or RDRF flag is set to 1) 3. When 1 is received as the acknowledge bit when the ACKE bit is 1 (when the ACKB bit is set to 1) 4. When a stop condition is detected (when the STOP or ESTP flag is set to 1) • Synchronous serial format, and formatless mode <ol style="list-style-type: none"> 1. At the end of data transfer (when the TDRE or RDRF flag is set to 1) 2. When a start condition is detected with serial format selected 3. When the SW bit is set to 1 in DDGCSWR <p>Except for above, when the condition to set the TDRE or RDRF internal flag to 1 is generated.</p> |

When, with the I²C bus format selected, IRIC is set to 1 and an interrupt is generated, other flags must be checked in order to identify the source that set IRIC to 1. Although each source has a corresponding flag, caution is needed at the end of a transfer.

When the TDRE or RDRF internal flag is set, the readable IRTR flag may or may not be set. The IRTR flag (the DTC start request flag) is not set at the end of a data transfer up to detection of a retransmission start condition or stop condition after a slave address (SVA) or general call address match in I²C bus format slave mode.

Even when the IRIC flag and IRTR flag are set, the TDRE or RDRF internal flag may not be set. The IRIC and IRTR flags are not cleared at the end of the specified number of transfers in continuous transfer using the DTC. The TDRE or RDRF flag is cleared, however, since the specified number of ICDR reads or writes have been completed.

Table 16.3 shows the relationship between the flags and the transfer states.

Table 16.3 Flags and Transfer States

| MST | TRS | BBSY | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | State |
|-----|-----|------|------|------|------|------|----|-----|-----|------|---|
| 1/0 | 1/0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Idle state (flag clearing required) |
| 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Start condition issuance |
| 1 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | Start condition established |
| 1 | 1/0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0/1 | Master mode wait |
| 1 | 1/0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0/1 | Master mode transmit/receive end |
| 0 | 0 | 1 | 0 | 0 | 0 | 1/0 | 1 | 1/0 | 1/0 | 0 | Arbitration lost |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | SAR match by first frame in slave mode |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | General call address match |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | SARX match |
| 0 | 1/0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0/1 | Slave mode transmit/receive end (except after SARX match) |
| 0 | 1/0 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | Slave mode transmit/receive end (after SARX match) |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | Slave mode transmit/receive end (after SARX match) |
| 0 | 1/0 | 0 | 1/0 | 1/0 | 0 | 0 | 0 | 0 | 0 | 0/1 | Stop condition detected |

Bit 0—Start Condition/Stop Condition Prohibit (SCP): Controls the issuing of start and stop conditions in master mode. To issue a start condition, write 1 in BBSY and 0 in SCP. A retransmit start condition is issued in the same way. To issue a stop condition, write 0 in BBSY and 0 in SCP. This bit is always read as 1. If 1 is written, the data is not stored.

Bit 0

| SCP | Description |
|-----|---|
| 0 | Writing 0 issues a start or stop condition, in combination with the BBSY flag |
| 1 | Reading always returns a value of 1 (Initial value) Writing is ignored |

16.2.6 I²C Bus Status Register (ICSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|------|
| | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/W |

Note: * Only 0 can be written, to clear the flags.

ICSR is an 8-bit readable/writable register that performs flag confirmation and acknowledge confirmation and control.

ICSR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Error Stop Condition Detection Flag (ESTP): Indicates that a stop condition has been detected during frame transfer in I²C bus format slave mode.

Bit 7

| ESTP | Description |
|------|--|
| 0 | No error stop condition (Initial value) [Clearing conditions] <ol style="list-style-type: none"> When 0 is written in ESTP after reading ESTP = 1 When the IRIC flag is cleared to 0 |
| 1 | <ul style="list-style-type: none"> In I²C bus format slave mode Error stop condition detected [Setting condition] When a stop condition is detected during frame transfer In other modes No meaning |

Bit 6—Normal Stop Condition Detection Flag (STOP): Indicates that a stop condition has been detected after completion of frame transfer in I²C bus format slave mode.

Bit 6

| STOP | Description |
|------|--|
| 0 | No normal stop condition (Initial value) [Clearing conditions] <ol style="list-style-type: none"> When 0 is written in STOP after reading STOP = 1 When the IRIC flag is cleared to 0 |
| 1 | <ul style="list-style-type: none"> In I²C bus format slave mode Normal stop condition detected [Setting condition] When a stop condition is detected after completion of frame transfer In other modes No meaning |

Bit 5—I²C Bus Interface Continuous Transmission/Reception Interrupt Request Flag

(IRTR): Indicates that the I²C bus interface has issued an interrupt request to the CPU, and the source is completion of reception/transmission of one frame in continuous transmission/reception for which DTC activation is possible. When the IRTR flag is set to 1, the IRIC flag is also set to 1 at the same time.

IRTR flag setting is performed when the TDRE or RDRF flag is set to 1. IRTR is cleared by reading IRTR after it has been set to 1, then writing 0 in IRTR. IRTR is also cleared automatically when the IRIC flag is cleared to 0.

Bit 5

| IRTR | Description |
|------|--|
| 0 | Waiting for transfer, or transfer in progress [Clearing conditions] 1. When 0 is written in IRTR after reading IRTR = 1 2. When the IRIC flag is cleared to 0 |
| 1 | Continuous transfer state [Setting conditions] <ul style="list-style-type: none"> In I²C bus interface slave mode When the TDRE or RDRF flag is set to 1 when AASX = 1 In other modes When the TDRE or RDRF flag is set to 1 |

Bit 4—Second Slave Address Recognition Flag (AASX): In I²C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition matches bits SVAX6 to SVAX0 in SARX.

AASX is cleared by reading AASX after it has been set to 1, then writing 0 in AASX. AASX is also cleared automatically when a start condition is detected.

Bit 4

| AASX | Description |
|------|---|
| 0 | Second slave address not recognized (Initial value) [Clearing conditions] 1. When 0 is written in AASX after reading AASX = 1 2. When a start condition is detected 3. In master mode |
| 1 | Second slave address recognized [Setting condition] When the second slave address is detected in slave receive mode while FSX = 0 |

Bit 3—Arbitration Lost (AL): This flag indicates that arbitration was lost in master mode. The I²C bus interface monitors the bus. When two or more master devices attempt to seize the bus at nearly the same time, if the I²C bus interface detects data differing from the data it sent, it sets AL to 1 to indicate that the bus has been taken by another master.

AL is cleared by reading AL after it has been set to 1, then writing 0 in AL. In addition, AL is reset automatically by write access to ICDR in transmit mode, or read access to ICDR in receive mode.

Bit 3

| AL | Description |
|----|--|
| 0 | Bus arbitration won (Initial value) [Clearing conditions] 1. When ICDR data is written (transmit mode) or read (receive mode) 2. When 0 is written in AL after reading AL = 1 |
| 1 | Arbitration lost [Setting conditions] 1. If the internal SDA and SDA pin disagree at the rise of SCL in master transmit mode 2. If the internal SCL line is high at the fall of SCL in master transmit mode |

Bit 2—Slave Address Recognition Flag (AAS): In I²C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition matches bits SVA6 to SVA0 in SAR, or if the general call address (H'00) is detected.

AAS is cleared by reading AAS after it has been set to 1, then writing 0 in AAS. In addition, AAS is reset automatically by write access to ICDR in transmit mode, or read access to ICDR in receive mode.

Bit 2

| AAS | Description |
|------------|--|
| 0 | Slave address or general call address not recognized (Initial value) [Clearing conditions] 1. When ICDR data is written (transmit mode) or read (receive mode) 2. When 0 is written in AAS after reading AAS = 1 3. In master mode |
| 1 | Slave address or general call address recognized [Setting condition] When the slave address or general call address is detected in slave receive mode while FS = 0 |

Bit 1—General Call Address Recognition Flag (ADZ): In I²C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition is the general call address (H'00).

ADZ is cleared by reading ADZ after it has been set to 1, then writing 0 in ADZ. In addition, ADZ is reset automatically by write access to ICDR in transmit mode, or read access to ICDR in receive mode.

Bit 1

| ADZ | Description |
|------------|---|
| 0 | General call address not recognized (Initial value) [Clearing conditions] 1. When ICDR data is written (transmit mode) or read (receive mode) 2. When 0 is written in ADZ after reading ADZ = 1 3. In master mode |
| 1 | General call address recognized [Setting condition] When the general call address is detected in slave receive mode while FSX = 0 or FS = 0 |

Bit 0—Acknowledge Bit (ACKB): Stores acknowledge data. In transmit mode, after the receiving device receives data, it returns acknowledge data, and this data is loaded into ACKB. In receive mode, after data has been received, the acknowledge data set in this bit is sent to the transmitting device.

When this bit is read, in transmission (when TRS = 1), the value loaded from the bus line (returned by the receiving device) is read. In reception (when TRS = 0), the value set by internal software is read.

When this bit is written to, the acknowledge data transmitted at the receipt is rewritten regardless of the TRS value. The data loaded from the receiving device is retained, therefore take care of using bit-manipulation instructions.

Bit 0

| ACKB | Description |
|------|--|
| 0 | Receive mode: 0 is output at acknowledge output timing (Initial value) Transmit mode: Indicates that the receiving device has acknowledged the data (signal is 0) |
| 1 | Receive mode: 1 is output at acknowledge output timing Transmit mode: Indicates that the receiving device has not acknowledged the data (signal is 1) |

16.2.7 Serial Timer Control Register (STCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-------|-------|------|-------|-----|-------|-------|
| | — | IICX1 | IICX0 | IICE | FLSHE | — | ICKS1 | ICKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

STCR is an 8-bit readable/writable register that controls register access, the I²C interface operating mode (when the on-chip IIC option is included), and on-chip flash memory (F-ZTAT versions), and selects the TCNT input clock source. For details of functions not related to the I²C bus interface, see section 3.2.4, Serial Timer Control Register (STCR), and the descriptions of the relevant modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Reserved: Do not write 1 to this bit.

Bits 6 and 5—I²C Transfer Select 1 and 0 (IICX1, IICX0): These bits, together with bits CKS2 to CKS0 in ICMR of IIC1, select the transfer rate in master mode. For details, see section 16.2.4, I²C Bus Mode Register (ICMR).

Bit 4—I²C Master Enable (IICE): Controls CPU access to the I²C bus interface data and control registers (ICCR, ICSR, ICDR/SARX, ICMR/SAR).

Bit 4

| IICE | Description |
|------|---|
| 0 | CPU access to I ² C bus interface data and control registers is disabled (Initial value) |
| 1 | CPU access to I ² C bus interface data and control registers is enabled |

Bit 3—Flash Memory Control Register Enable (FLSHE): Controls the operation of the flash memory in F-ZTAT versions. For details, see section 21, ROM (Mask ROM Version, H8S/2138 F-ZTAT, H8S/2134 F-ZTAT, and H8S/2132 F-ZTAT), and section 22, ROM (H8S/2138 F-ZTAT A-Mask Version, H8S/2134 F-ZTAT A-Mask Version).

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Source Select 1 and 0 (ICKS1, ICKS0): These bits, together with bits CKS2 to CKS0 in TCR, select the clock input to the timer counters (TCNT). For details, see section 12.2.4, Timer Control Register (TCR).

16.2.8 DDC Switch Register (DDCSWR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|---------|------|------|------|------|
| | SWE | SW | IE | IF | CLR3 | CLR2 | CLR1 | CLR0 |
| Initial value | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/(W)*1 | W*2 | W*2 | W*2 | W*2 |

- Notes: 1. Only 0 can be written, to clear the flag.
2. Always read as 1.

DDCSWR is an 8-bit readable/writable register that controls the IIC channel 0 automatic format switching function.

DDCSWR is initialized to H'0F by a reset and in hardware standby mode.

Bit 7—DDC Mode Switch Enable (SWE): Selects the function for automatically switching IIC channel 0 from formatless mode to the I²C bus format.

Bit 7

| SWE | Description |
|-----|--|
| 0 | Automatic switching of IIC channel 0 from formatless mode to I ² C bus format is disabled (Initial value) |
| 1 | Automatic switching of IIC channel 0 from formatless mode to I ² C bus format is enabled |

Bit 6—DDC Mode Switch (SW): Selects either formatless mode or the I²C bus format for IIC channel 0.

Bit 6

| SW | Description |
|----|---|
| 0 | IIC channel 0 is used with the I ² C bus format (Initial value) [Clearing conditions] 1. When 0 is written by software 2. When a falling edge is detected on the SCL pin when SWE = 1 |
| 1 | IIC channel 0 is used in formatless mode [Setting condition] When 1 is written in SW after reading SW = 0 |

Bit 5—DDC Mode Switch Interrupt Enable Bit (IE): Enables or disables an interrupt request to the CPU when automatic format switching is executed for IIC channel 0.

Bit 5

| IE | Description |
|----|---|
| 0 | Interrupt when automatic format switching is executed is disabled (Initial value) |
| 1 | Interrupt when automatic format switching is executed is enabled |

Bit 4—DDC Mode Switch Interrupt Flag (IF): Flag that indicates an interrupt request to the CPU when automatic format switching is executed for IIC channel 0.

Bit 4

| IF | Description |
|----|---|
| 0 | No interrupt is requested when automatic format switching is executed (Initial value) [Clearing condition] When 0 is written in IF after reading IF = 1 |
| 1 | An interrupt is requested when automatic format switching is executed [Setting condition] When a falling edge is detected on the SCL pin when SWE = 1 |

Bits 3 to 0—IIC Clear 3 to 0 (CLR3 to CLR0): These bits control initialization of the internal state of IIC0 and IIC1.

These bits can only be written to; if read they will always return a value of 1.

When a write operation is performed on these bits, a clear signal is generated for the internal latch circuit of the corresponding module(s), and the internal state of the IIC module(s) is initialized.

The write data for these bits is not retained. To perform IIC clearance, bits CLR3 to CLR0 must be written to simultaneously using an MOV instruction. Do not use a bit manipulation instruction such as BCLR.

When clearing is required again, all the bits must be written to in accordance with the setting.

| Bit 3 | Bit 2 | Bit 1 | Bit 0 | Description |
|-------|-------|-------|-------|--|
| CLR3 | CLR2 | CLR1 | CLR0 | |
| 0 | 0 | — | — | Setting prohibited |
| | | | 0 | Setting prohibited |
| | 1 | 0 | 0 | IIC0 internal latch cleared |
| | | | 1 | IIC1 internal latch cleared |
| 1 | — | — | 0 | IIC0 and IIC1 internal latches cleared |
| | | | 1 | Invalid setting |

16.2.9 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP4 or MSTP3 bit is set to 1, operation of the corresponding IIC channel is halted at the end of the bus cycle, and a transition is made to module stop mode. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRL Bit 4—Module Stop (MSTP4): Specifies IIC channel 0 module stop mode.

MSTPCRL

Bit 4

| MSTP4 | Description |
|-------|---|
| 0 | IIC channel 0 module stop mode is cleared |
| 1 | IIC channel 0 module stop mode is set (Initial value) |

MSTPCRL Bit 3—Module Stop (MSTP3): Specifies IIC channel 1 module stop mode.

MSTPCRL

Bit 3

| MSTP3 | Description |
|-------|---|
| 0 | IIC channel 1 module stop mode is cleared |
| 1 | IIC channel 1 module stop mode is set (Initial value) |

16.3 Operation

16.3.1 I²C Bus Data Format

The I²C bus interface has serial and I²C bus formats.

The I²C bus formats are addressing formats with an acknowledge bit. These are shown in (a) and (b) in figure 16.3. The first frame following a start condition always consists of 8 bits.

IIC channel 0 only is capable of formatless operation, as shown in figure 16.4.

The serial format is a non-addressing format with no acknowledge bit. This is shown in figure 16.5.

Figure 16.6 shows the I²C bus timing.

The symbols used in figures 16.3 to 16.6 are explained in table 16.4.

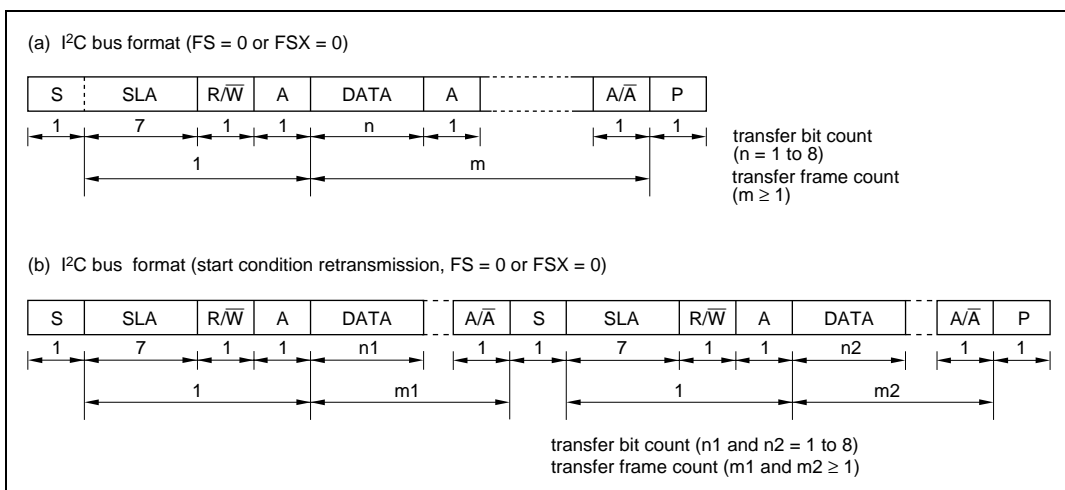


Figure 16.3 I²C Bus Data Formats (I²C Bus Formats)

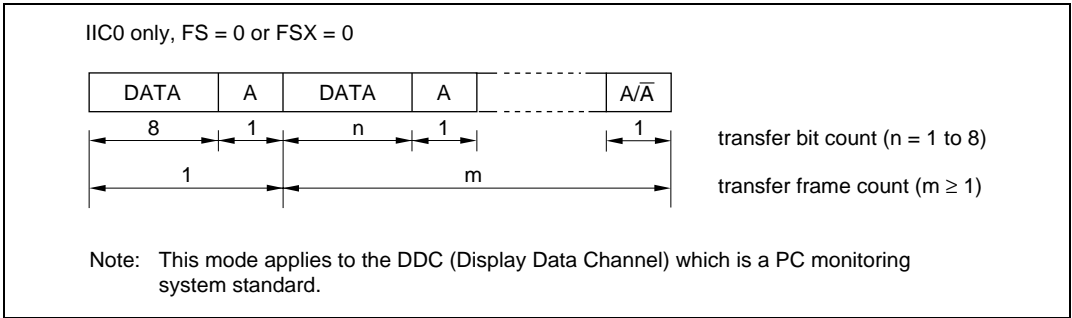


Figure 16.4 Formatless

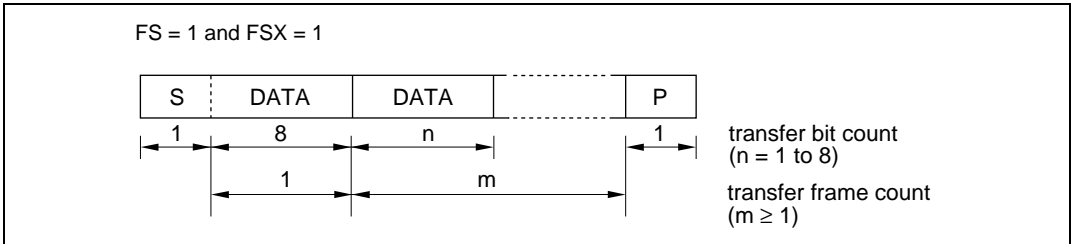


Figure 16.5 I²C Bus Data Format (Serial Format)

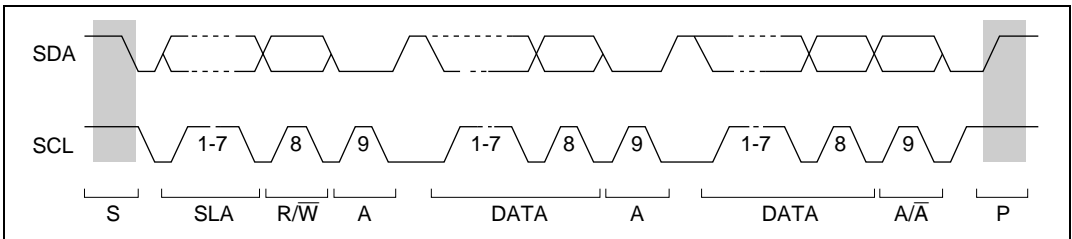


Figure 16.6 I²C Bus Timing

Table 16.4 I²C Bus Data Format Symbols**Legend**

| | |
|-------------------|---|
| S | Start condition. The master device drives SDA from high to low while SCL is high |
| SLA | Slave address, by which the master device selects a slave device |
| R/ \overline{W} | Indicates the direction of data transfer: from the slave device to the master device when R/ \overline{W} is 1, or from the master device to the slave device when R/ \overline{W} is 0 |
| A | Acknowledge. The receiving device (the slave in master transmit mode, or the master in master receive mode) drives SDA low to acknowledge a transfer |
| DATA | Transferred data. The bit length is set by bits BC2 to BC0 in ICMR. The MSB-first or LSB-first format is selected by bit MLS in ICMR |
| P | Stop condition. The master device drives SDA from low to high while SCL is high |

16.3.2 Master Transmit Operation

In I²C bus format master transmit mode, the master device outputs the transmit clock and transmit data, and the slave device returns an acknowledge signal.

The transmission procedure and operations by which data is sequentially transmitted in synchronization with ICDR write operations, are described below.

- [1] Set the ICE bit in ICCR to 1. Set bits MLS, WAIT, and CKS2 to CKS0 in ICMR, and bit IICX in STCR, according to the operation mode.
- [2] Read the BBSY flag to confirm that the bus is free.
- [3] Set the MST and TRS bits to 1 in ICCR to select master transmit mode.
- [4] Write 1 to BBSY and 0 to SCP. This switches SDA from high to low when SCL is high, and generates the start condition.
- [5] When the start condition is generated, the IRIC and IRTR flags are set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU.
- [6] Write data to ICDR (slave address + R/ \overline{W})
 With the I²C bus format (when the FS bit in SAR or the FSX bit in SARX is 0), the first frame data following the start condition indicates the 7-bit slave address and transmit/receive direction.
 Then clear the IRIC flag to indicate the end of transfer.

Writing to ICDR and clearing of the IRIC flag must be executed continuously, so that no interrupt is inserted.

If a period of time that is equal to transfer one byte has elapsed by the time the IRIC flag is cleared, the end of transfer cannot be identified.

The master device sequentially sends the transmit clock and the data written to ICDR with the timing shown in figure 16.7. The selected slave device (i.e., the slave device with the matching slave address) drives SDA low at the 9th transmit clock pulse and returns an acknowledge signal.

- [7] When one frame of data has been transmitted, the IRIC flag is set to 1 at the rise of the 9th transmit clock pulse. After one frame has been transmitted, SCL is automatically fixed low in synchronization with the internal clock until the next transmit data is written.
- [8] Read the ACKB bit to confirm that ACKB is 0. When the slave device has not returned an acknowledge signal and ACKB remains 1, execute the transmit end processing described in step [12] and perform transmit operation again.
- [9] Write the next data to be transmitted in ICDR. To indicate the end of data transfer, clear the IRIC flag to 0.
As described in step [6] above, writing to ICDR and clearing of the IRIC flag must be executed continuously so that no interrupt is inserted.
The next frame is transmitted in synchronization with the internal clock.
- [10] When one frame of data has been transmitted, the IRIC flag is set to 1 at the rise of the 9th transmit clock pulse. After one frame has been transmitted, SCL is automatically fixed low in synchronization with the internal clock until the next transmit data is written.
- [11] Read the ACKB bit of ICSR. Confirm that the slave device has returned an acknowledge signal and ACKB is 0. When more data is to be transmitted, return to step [9] to execute next transmit operation. If the slave device has not returned an acknowledge signal and ACKB is 1, execute the transmit end processing described in step [12].
- [12] Clear the IRIC flag to 0. Write BBSY and SCP of ICCR to 0. By doing so, SDA is changed from low to high while SCL is high and the transmit stop condition is generated.

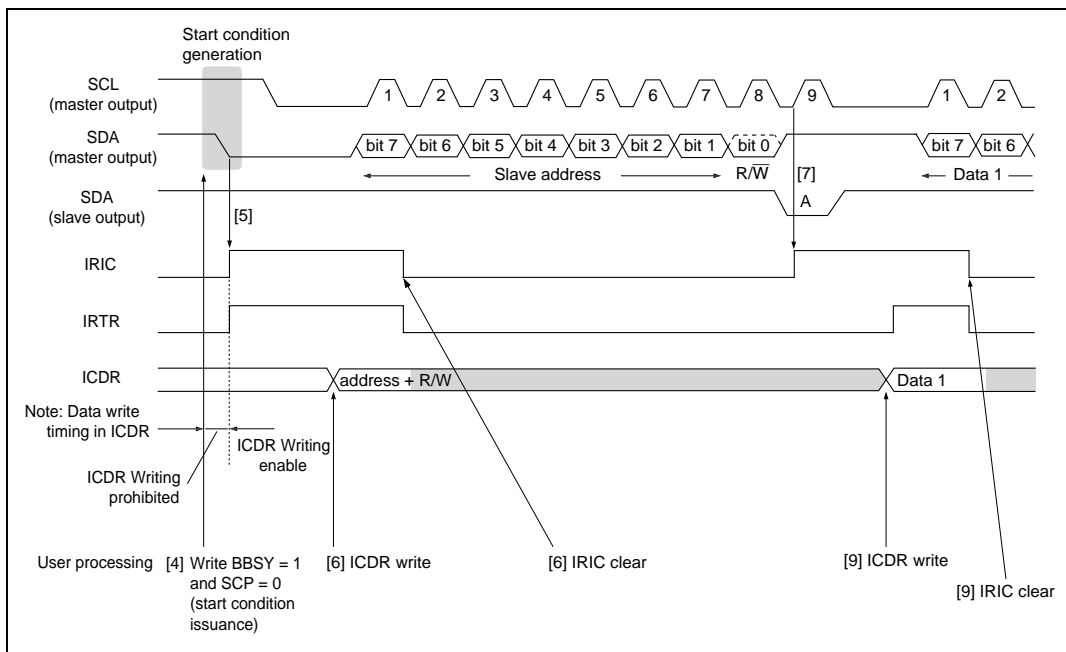


Figure 16.7 Example of Master Transmit Mode Operation Timing
(MLS = WAIT = 0)

16.3.3 Master Receive Operation

In master receive mode, the master device outputs the receive clock, receives data, and returns an acknowledge signal. The slave device transmits data.

The receive procedure and operations by which data is sequentially received in synchronization with ICDR read operations, are described below.

- [1] Clear the TRS bit of ICCR to 0 and switch from transmit mode to receive mode. Set the WAIT bit to 1 and clear the ACKB bit of ICSR to 0 (acknowledge data setting).
- [2] When ICDR is read (dummy data read), reception is started and the receive clock is output, and data is received, in synchronization with the internal clock. To indicate the wait, clear the IRIC flag to 0.

Reading from ICDR and clearing of the IRIC flag must be executed continuously so that no interrupt is inserted.

If a period of time that is equal to transfer one byte has elapsed by the time the IRIC flag is cleared, the end of transfer cannot be identified.

- [3] The IRIC flag is set to 1 at the fall of the 8th clock of a one-frame reception clock. At this point, if the IEIC bit of ICCR is set to 1, an interrupt request is generated to the CPU. SCL is automatically fixed low in synchronization with the internal clock until the IRIC flag is cleared. If the first frame is the final reception frame, execute the end processing as described in [10].
- [4] Clear the IRIC flag to 0 to release from the wait state.
The master device outputs the 9th receive clock pulse, sets SDA to low, and returns an acknowledge signal.
- [5] When one frame of data has been transmitted, the IRIC and IRTR flags are set to 1 at the rise of the 9th transmit clock pulse.
The master device continues to output the receive clock for the next receive data.
- [6] Read the ICDR receive data.
- [7] Clear the IRIC flag to indicate the next wait.
From clearing of the IRIC flag to completion of data reception as described in steps [5], [6], and [7], must be performed within the time taken to transfer one byte because releasing of the wait state as described in step [4] (or [9]).
- [8] The IRIC flag is set to 1 at the fall of the 8th receive clock pulse. SCL is automatically fixed low in synchronization with the internal clock until the IRIC flag is cleared. If this frame is the final reception frame, execute the end processing as described in [10].
- [9] Clear the IRIC flag to 0 to release from the wait state. The master device outputs the 9th reception clock pulse, sets SDA to low, and returns an acknowledge signal.
By repeating steps [5] to [9] above, more data can be received.
- [10] Set the ACKB bit of ICSR to 1 and set the acknowledge data for the final reception.
Set the TRS bit of ICCR to 1 to change receive mode to transmit mode.
- [11] Clear the IRIC flag to release from the wait state.
- [12] When one frame of data has been received, the IRIC flag is set to 1 at the rise of the 9th reception clock pulse.
- [13] Clear the WAIT bit of ICMR to 0 to cancel wait mode. Read the ICDR receive data and clear the IRIC flag to 0.
Clear the IRIC flag only when WAIT = 0.
(If the stop-condition generation command is executed after clearing the IRIC flag to 0 and

then clearing the WAIT bit to 0, the SDA line is fixed low and the stop condition cannot be generated.)

[14] Write 0 to BBSY and SCP. This changes SDA from low to high when SCL is high, and generates the stop condition.

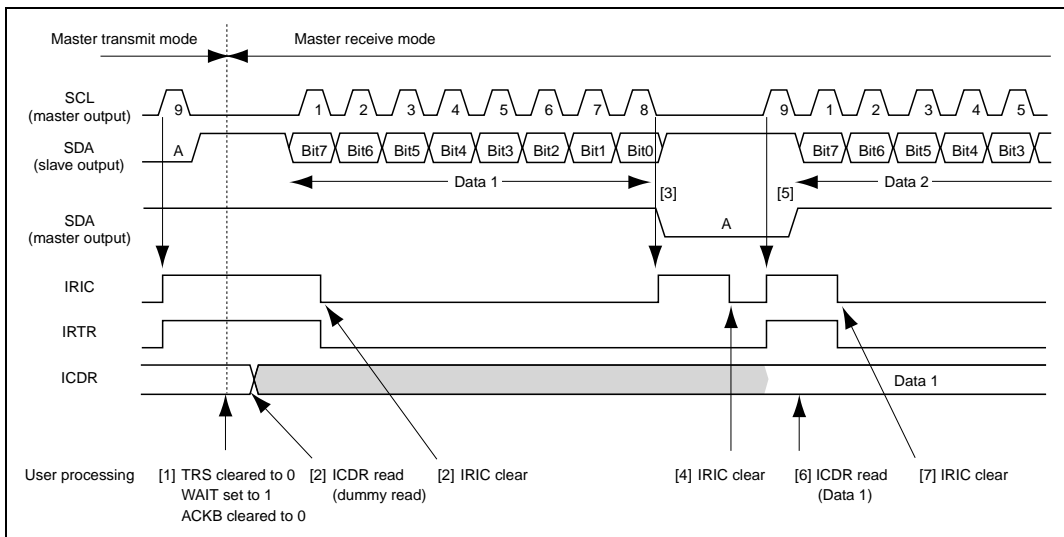


Figure 16.8 (a) Example of Master Receive Mode Operation Timing
(MLS = ACKB = 0, WAIT = 1)

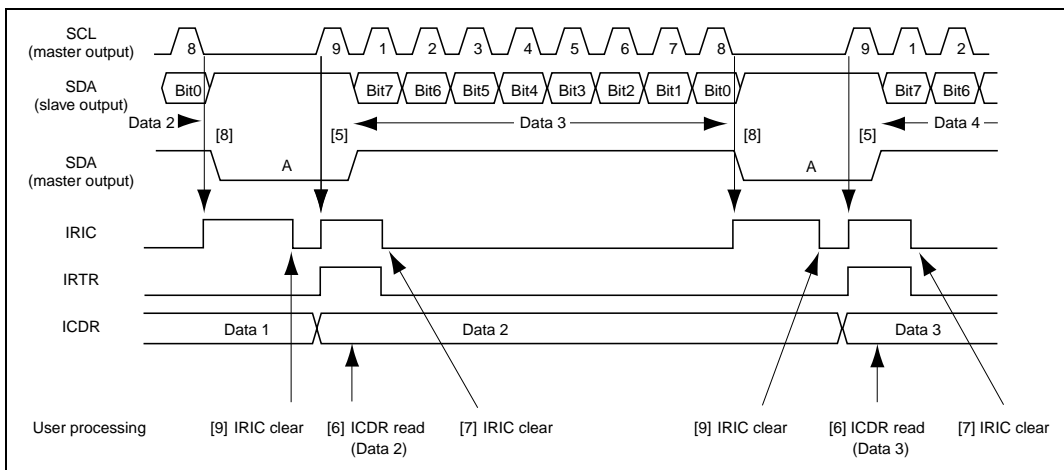


Figure 16.8 (b) Example of Master Receive Mode Operation Timing
(MLS = ACKB = 0, WAIT = 1) (cont)

16.3.4 Slave Receive Operation

In slave receive mode, the master device outputs the transmit clock and transmit data, and the slave device returns an acknowledge signal. The reception procedure and operations in slave receive mode are described below.

- [1] Set the ICE bit in ICCR to 1. Set the MLS bit in ICMR and the MST and TRS bits in ICCR according to the operating mode.
- [2] When the start condition output by the master device is detected, the BBSY flag in ICCR is set to 1.
- [3] When the slave address matches in the first frame following the start condition, the device operates as the slave device specified by the master device. If the 8th data bit (R/\overline{W}) is 0, the TRS bit in ICCR remains cleared to 0, and slave receive operation is performed.
- [4] At the 9th clock pulse of the receive frame, the slave device drives SDA low and returns an acknowledge signal. At the same time, the IRIC flag in ICCR is set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU. If the RDRF internal flag has been cleared to 0, it is set to 1, and the receive operation continues. If the RDRF internal flag has been set to 1, the slave device drives SCL low from the fall of the receive clock until data is read into ICDR.
- [5] Read ICDR and clear the IRIC flag in ICCR to 0. The RDRF flag is cleared to 0.
Receive operations can be performed continuously by repeating steps [4] and [5]. When SDA is changed from low to high when SCL is high, and the stop condition is detected, the BBSY flag in ICCR is cleared to 0.

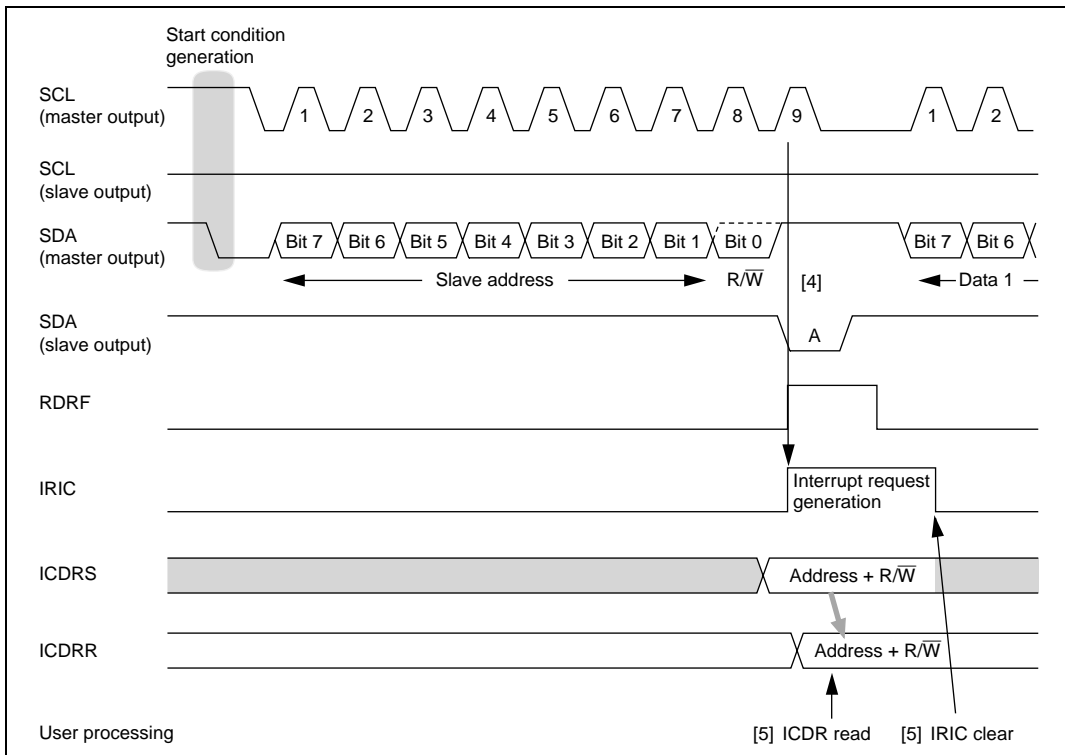


Figure 16.9 Example of Slave Receive Mode Operation Timing (1) ($MLS = ACKB = 0$)

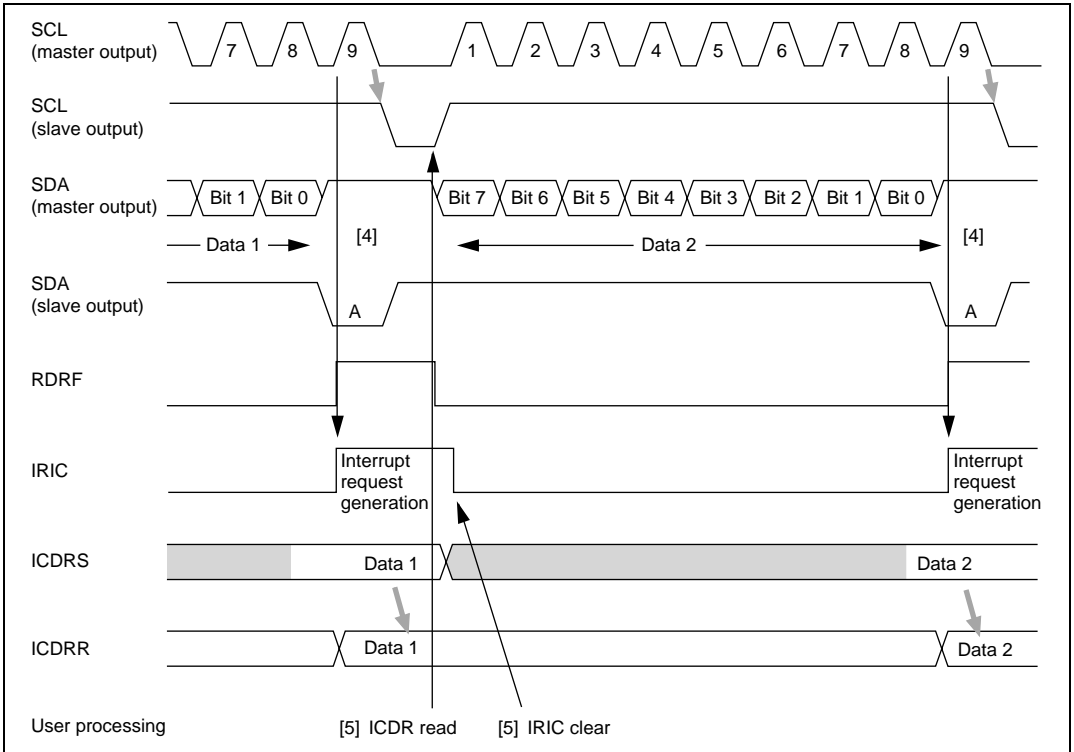


Figure 16.10 Example of Slave Receive Mode Operation Timing (2) ($MLS = ACKB = 0$)

16.3.5 Slave Transmit Operation

In slave transmit mode, the slave device outputs the transmit data, while the master device outputs the receive clock and returns an acknowledge signal. The transmission procedure and operations in slave transmit mode are described below.

- [1] Set the ICE bit in ICCR to 1. Set the MLS bit in ICMR and the MST and TRS bits in ICCR according to the operating mode.
- [2] When the slave address matches in the first frame following detection of the start condition, the slave device drives SDA low at the 9th clock pulse and returns an acknowledge signal. At the same time, the IRIC flag in ICCR is set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU. If the 8th data bit (R/\overline{W}) is 1, the TRS bit in ICCR is set to 1, and the mode changes to slave transmit mode automatically. The TDRE internal flag is set to 1. The slave device drives SCL low from the fall of the transmit clock until ICDR data is written.
- [3] After clearing the IRIC flag to 0, write data to ICDR. The TDRE internal flag is cleared to 0. The written data is transferred to ICDRS, and the TDRE internal flag and the IRIC and IRTR flags are set to 1 again. After clearing the IRIC flag to 0, write the next data to ICDR. The slave device sequentially sends the data written into ICDR in accordance with the clock output by the master device at the timing shown in figure 16.11.
- [4] When one frame of data has been transmitted, the IRIC flag in ICCR is set to 1 at the rise of the 9th transmit clock pulse. If the TDRE internal flag has been set to 1, this slave device drives SCL low from the fall of the transmit clock until data is written to ICDR. The master device drives SDA low at the 9th clock pulse, and returns an acknowledge signal. As this acknowledge signal is stored in the ACKB bit in ICSR, this bit can be used to determine whether the transfer operation was performed normally. When the TDRE internal flag is 0, the data written into ICDR is transferred to ICDRS, transmission is started, and the TDRE internal flag and the IRIC and IRTR flags are set to 1 again.
- [5] To continue transmission, clear the IRIC flag to 0, then write the next data to be transmitted into ICDR. The TDRE internal flag is cleared to 0.
Transmit operations can be performed continuously by repeating steps [4] and [5]. To end transmission, write H'FF to ICDR to release SDA on the slave side. When SDA is changed from low to high when SCL is high, and the stop condition is detected, the BBSY flag in ICCR is cleared to 0.

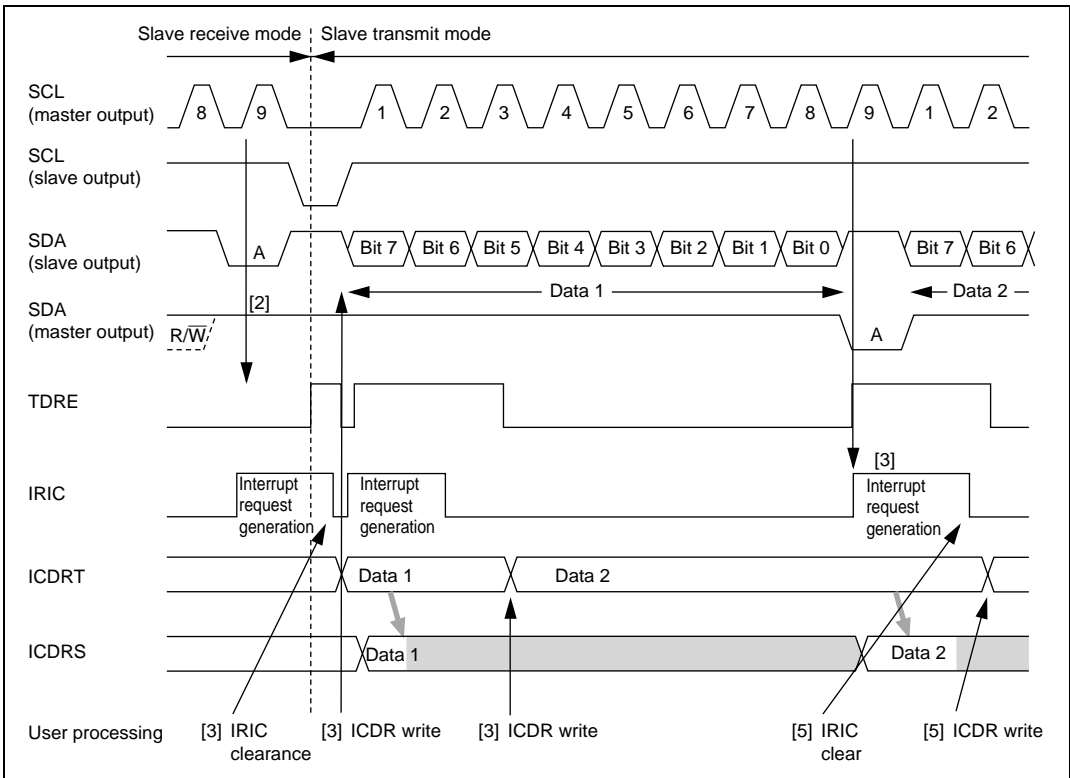


Figure 16.11 Example of Slave Transmit Mode Operation Timing (MLS = 0)

16.3.6 IRIC Setting Timing and SCL Control

The interrupt request flag (IRIC) is set at different times depending on the WAIT bit in ICMR, the FS bit in SAR, and the FSX bit in SARX. If the TDRE or RDRF internal flag is set to 1, SCL is automatically held low after one frame has been transferred; this timing is synchronized with the internal clock. Figure 16.12 shows the IRIC set timing and SCL control.

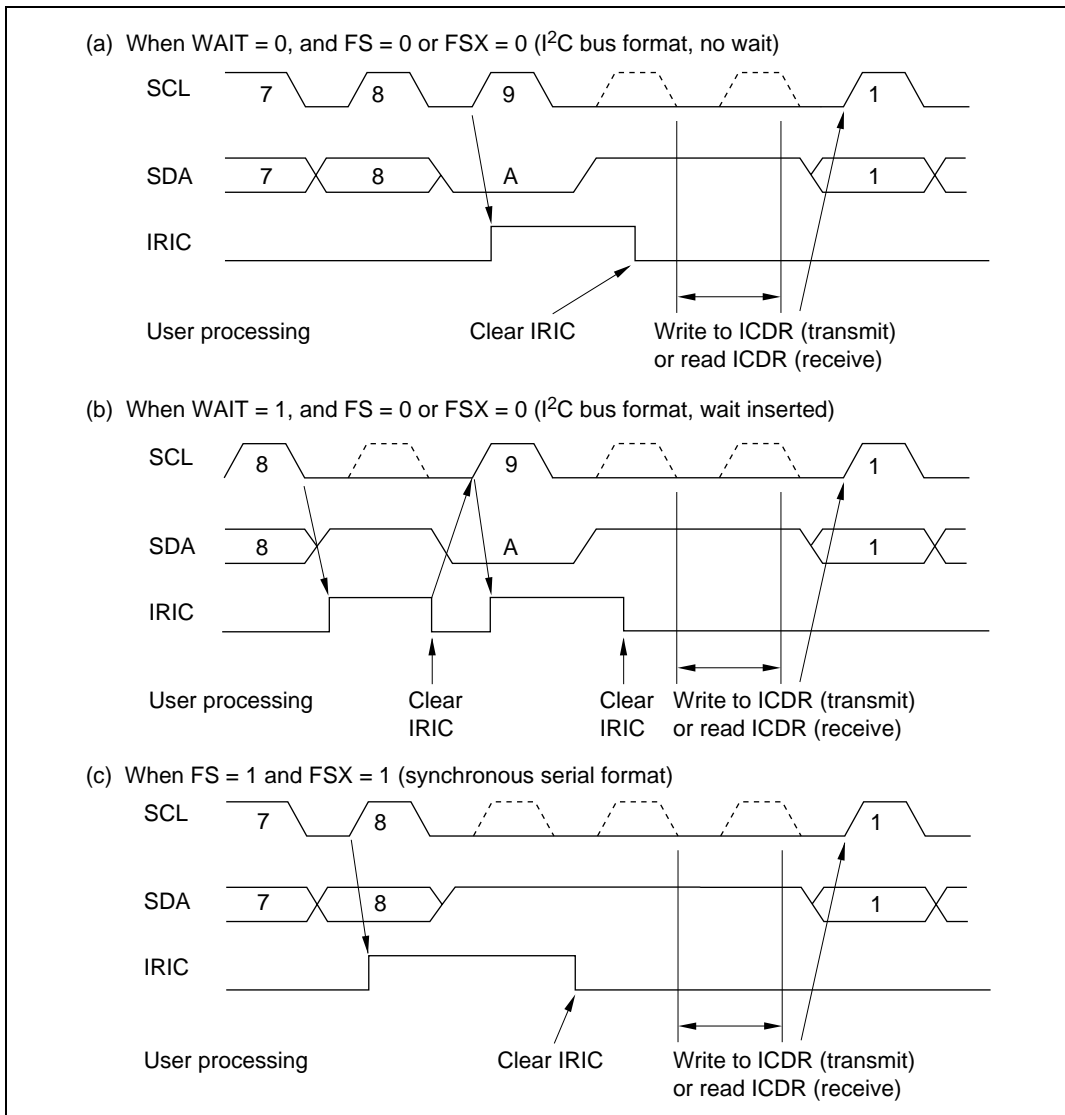


Figure 16.12 IRIC Setting Timing and SCL Control

16.3.7 Automatic Switching from Formatless Mode to I²C Bus Format

Setting the SW bit to 1 in DDCSWR enables formatless mode to be selected as the IIC0 operating mode. Switching from formatless mode to the I²C bus format (slave mode) is performed automatically when a falling edge is detected on the SCL pin.

The following four preconditions are necessary for this operation:

- A common data pin (SDA) for formatless and I²C bus format operation
- Separate clock pins for formatless operation (VSYNCl) and I²C bus format operation (SCL)
- A fixed 1 level for the SCL pin during formatless operation (the SCL pin does not output a low level)
- Settings of bits other than TRS in ICCR that allow I²C bus format operation

Automatic switching is performed from formatless mode to the I²C bus format when the SW bit in DDCSWR is automatically cleared to 0 on detection of a falling edge on the SCL pin. Switching from the I²C bus format to formatless mode is achieved by having software set the SW bit in DDCSWR to 1.

In formatless mode, bits (such as MSL and TRS) that control the I²C bus interface operating mode must not be modified. When switching from the I²C bus format to formatless mode, set the TRS bit to 1 or clear it to 0 according to the transmit data (transmission or reception) in formatless mode, then set the SW bit to 1. After automatic switching from formatless mode to the I²C bus format (slave mode), in order to wait for slave address reception, the TRS bit is automatically cleared to 0.

If a falling edge is detected on the SCL pin during formatless operation, I²C bus interface operating mode is switched to the I²C bus format without waiting for a stop condition to be detected.

16.3.8 Operation Using the DTC

The I²C bus format provides for selection of the slave device and transfer direction by means of the slave address and the R/W bit, confirmation of reception with the acknowledge bit, indication of the last frame, and so on. Therefore, continuous data transfer using the DTC must be carried out in conjunction with CPU processing by means of interrupts.

Table 16.5 shows some examples of processing using the DTC. These examples assume that the number of transfer data bytes is known in slave mode.

Table 16.5 Examples of Operation Using the DTC

| Item | Master Transmit Mode | Master Receive Mode | Slave Transmit Mode | Slave Receive Mode |
|---|---|----------------------------------|---|------------------------------|
| Slave address + R/W bit transmission/reception | Transmission by DTC (ICDR write) | Transmission by CPU (ICDR write) | Reception by CPU (ICDR read) | Reception by CPU (ICDR read) |
| Dummy data read | — | Processing by CPU (ICDR read) | — | — |
| Actual data transmission/reception | Transmission by DTC (ICDR write) | Reception by DTC (ICDR read) | Transmission by DTC (ICDR write) | Reception by DTC (ICDR read) |
| Dummy data (H'FF) write | — | — | Processing by DTC (ICDR write) | — |
| Last frame processing | Not necessary | Reception by CPU (ICDR read) | Not necessary | Reception by CPU (ICDR read) |
| Transfer request processing after last frame processing | 1st time: Clearing by CPU 2nd time: End condition issuance by CPU | Not necessary | Automatic clearing on detection of end condition during transmission of dummy data (H'FF) | Not necessary |
| Setting of number of DTC transfer data frames | Transmission: Actual data count + 1 (+1 equivalent to slave address + R/W bits) | Reception: Actual data count | Transmission: Actual data count + 1 (+1 equivalent to dummy data (H'FF)) | Reception: Actual data count |

16.3.9 Noise Canceler

The logic levels at the SCL and SDA pins are routed through noise cancelers before being latched internally. Figure 16.13 shows a block diagram of the noise canceler circuit.

The noise canceler consists of two cascaded latches and a match detector. The SCL (or SDA) input signal is sampled on the system clock, but is not passed forward to the next circuit unless the outputs of both latches agree. If they do not agree, the previous value is held.

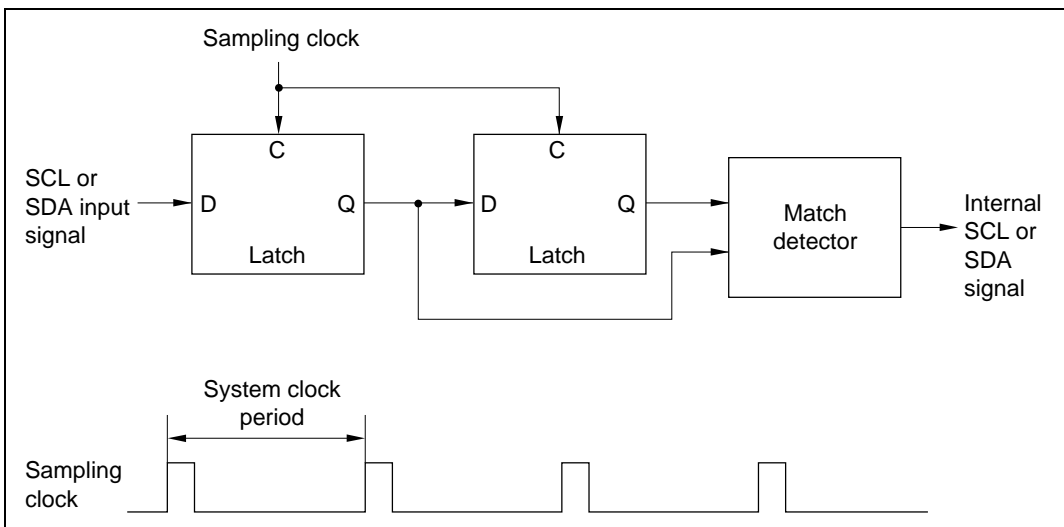


Figure 16.13 Block Diagram of Noise Canceler

16.3.10 Sample Flowcharts

Figures 16.14 to 16.17 show sample flowcharts for using the I²C bus interface in each mode.

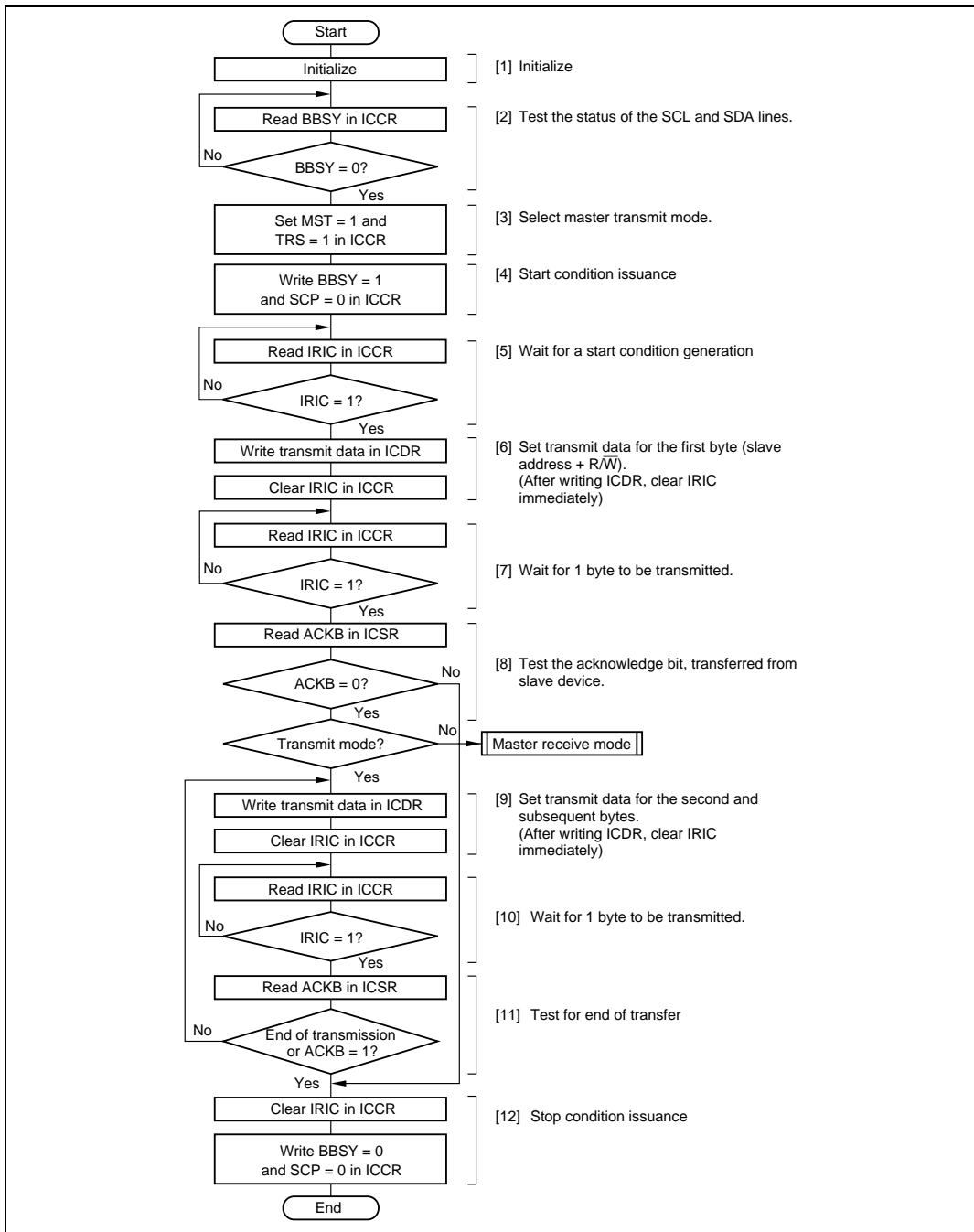


Figure 16.14 Flowchart for Master Transmit Mode (Example)

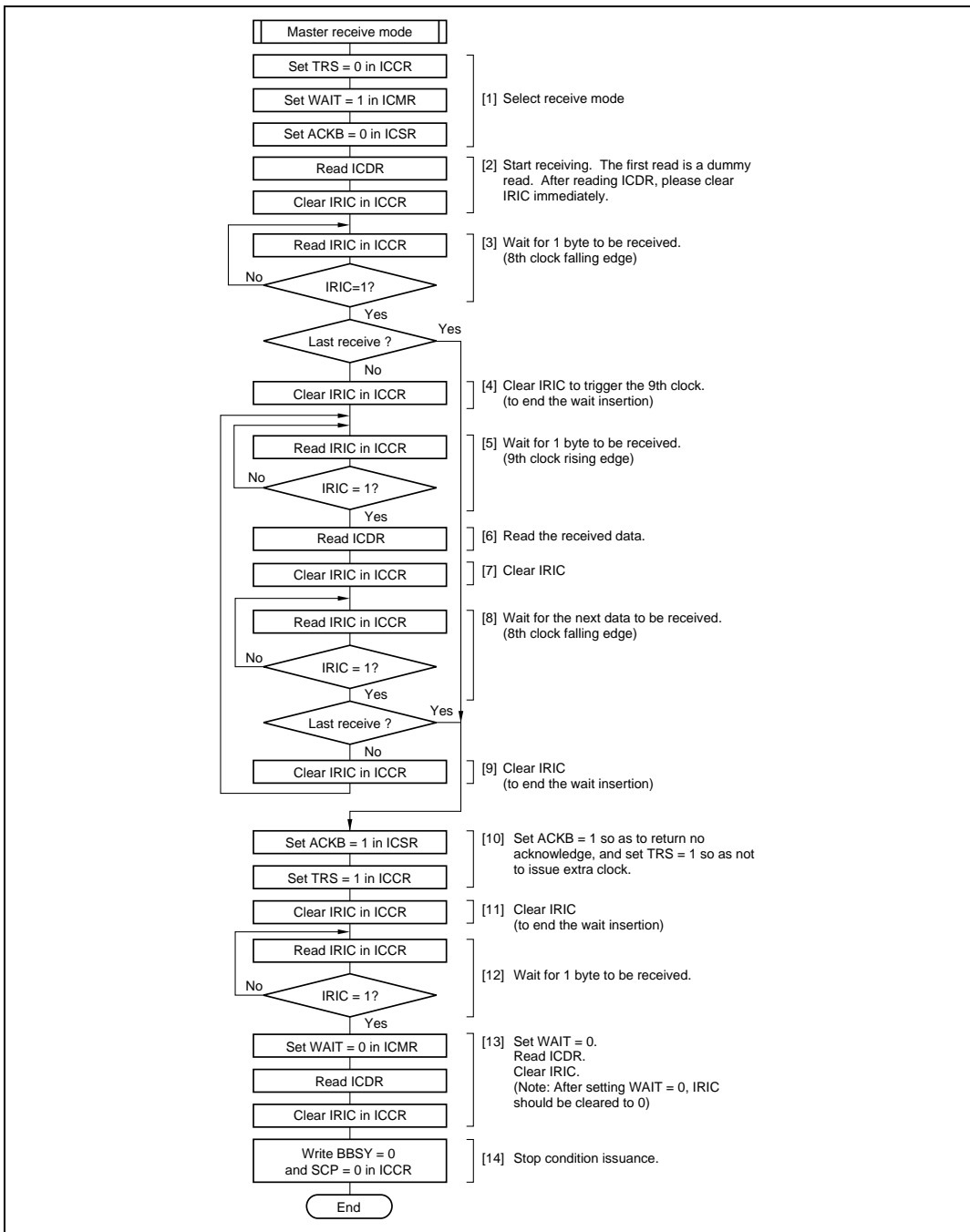


Figure 16.15 Flowchart for Master Receive Mode (Example)

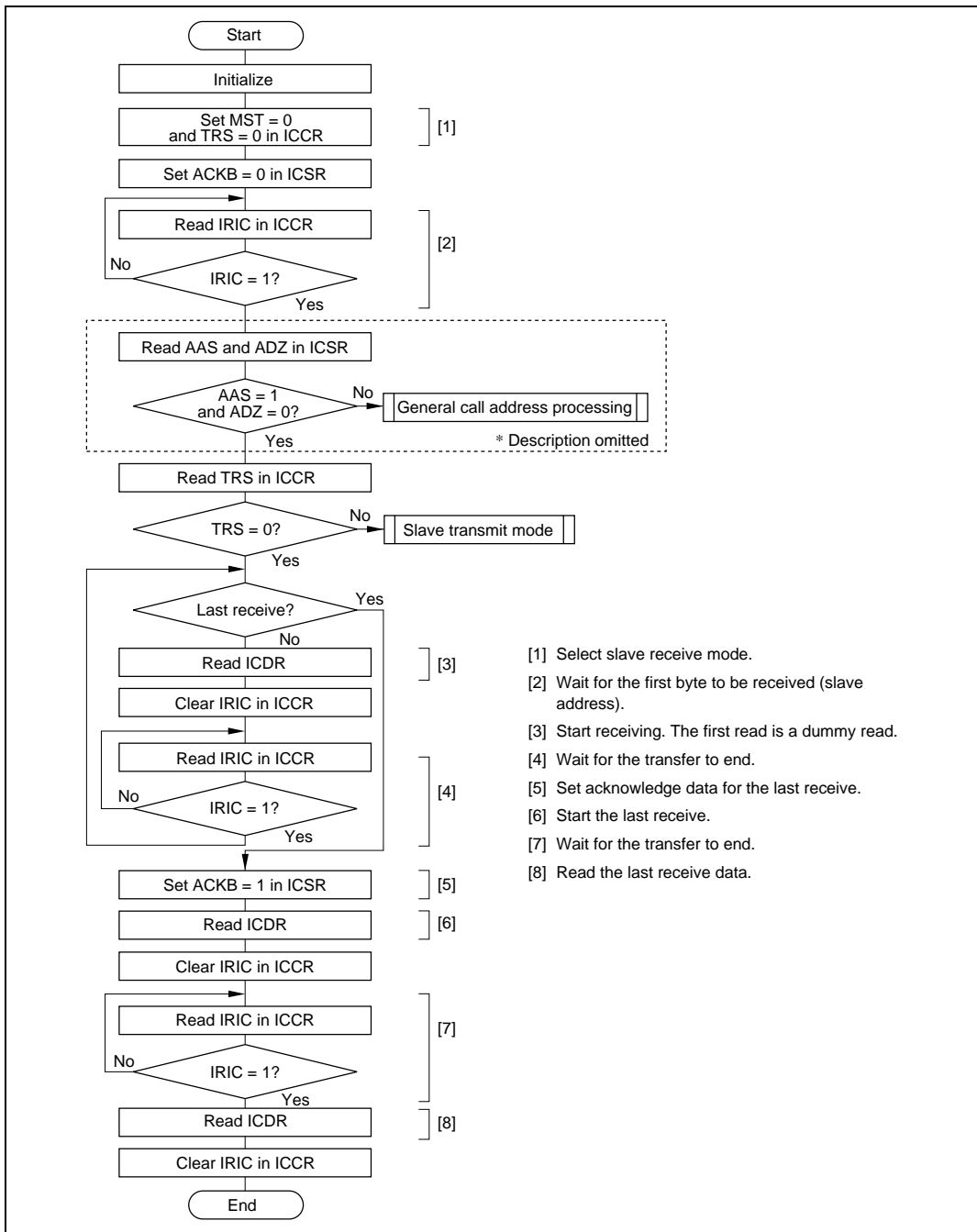


Figure 16.16 Flowchart for Slave Receive Mode (Example)

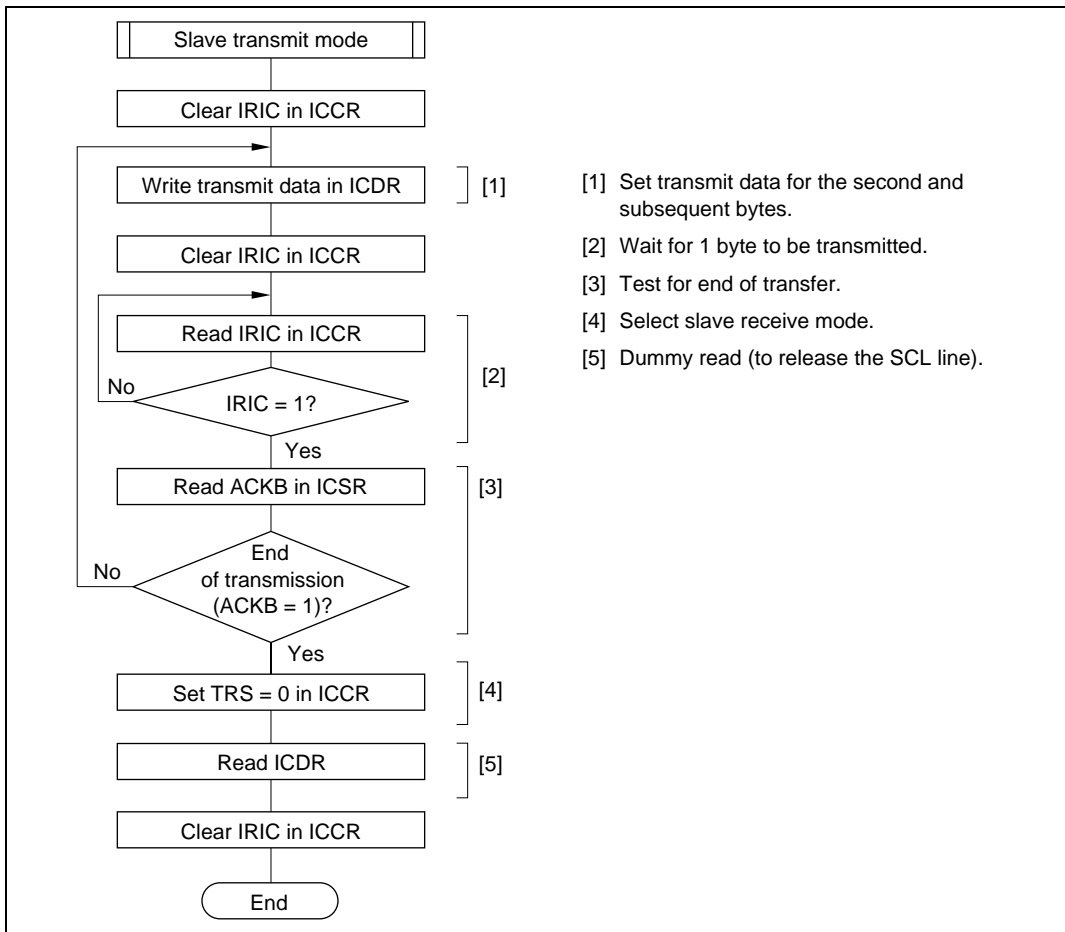


Figure 16.17 Flowchart for Slave Transmit Mode (Example)

16.3.11 Initialization of Internal State

The IIC has a function for forcible initialization of its internal state if a deadlock occurs during communication.

Initialization is executed in accordance with the setting of bits CLR3 to CLR0 in the DDCCSWR register or clearing ICE bit. For details of CLR3 to CLR0 bits setting, see section 16.2.8, DDC Switch Register (DDCCSWR).

Scope of Initialization: The initialization executed by this function covers the following items:

- TDRE and RDRF internal flags
- Transmit/receive sequencer and internal operating clock counter
- Internal latches for retaining the output state of the SCL and SDA pins (wait, clock, data output, etc.)

The following items are not initialized:

- Actual register values (ICDR, SAR, SARX, ICMR, ICCR, ICSR, DDCCSWR, STCR)
- Internal latches used to retain register read information for setting/clearing flags in the ICMR, ICCR, ICSR, and DDCCSWR registers
- The value of the ICMR register bit counter (BC2 to BC0)
- Generated interrupt sources (interrupt sources transferred to the interrupt controller)

Notes on Initialization:

- Interrupt flags and interrupt sources are not cleared, and so flag clearing measures must be taken as necessary.
- Basically, other register flags are not cleared either, and so flag clearing measures must be taken as necessary.
- When initialization is executed by DDCCSWR register, the write data for bits CLR3 to CLR0 is not retained. To perform IIC clearance, bits CLR3 to CLR0 must be written to simultaneously using an MOV instruction. Do not use a bit manipulation instruction such as BCLR. Similarly, when clearing is required again, all the bits must be written to simultaneously in accordance with the setting.
- If a flag clearing setting is made during transmission/reception, the IIC module will stop transmitting/receiving at that point and the SCL and SDA pins will be released. When transmission/reception is started again, register initialization, etc., must be carried out as necessary to enable correct communication as a system.

The value of the BBSY bit cannot be modified directly by this module clear function, but since the stop condition pin waveform is generated according to the state and release timing of the SCL and SDA pins, the BBSY bit may be cleared as a result. Similarly, state switching of other bits and flags may also have an effect.

To prevent problems caused by these factors, the following procedure should be used when initializing the IIC state.

1. Execute initialization of the internal state according to the setting of bits CLR3 to CLR0 or ICE bit clearing.
2. Execute a stop condition issuance instruction (write 0 to BBSY and SCP) to clear the BBSY bit to 0, and wait for two transfer rate clock cycles.
3. Re-execute initialization of the internal state according to the setting of bits CLR3 to CLR0 or ICE bit clearing.
4. Initialize (re-set) the IIC registers.

16.4 Usage Notes

- In master mode, if an instruction to generate a start condition is immediately followed by an instruction to generate a stop condition, neither condition will be output correctly. To output consecutive start and stop conditions, after issuing the instruction that generates the start condition, read the relevant ports, check that SCL and SDA are both low, then issue the instruction that generates the stop condition. Note that SCL may not yet have gone low when BBSY is cleared to 0.
- Either of the following two conditions will start the next transfer. Pay attention to these conditions when reading or writing to ICDR.
 - Write access to ICDR when ICE = 1 and TRS = 1 (including automatic transfer from ICDRT to ICDRS)
 - Read access to ICDR when ICE = 1 and TRS = 0 (including automatic transfer from ICDRS to ICDRR)
- Table 16.6 shows the timing of SCL and SDA output in synchronization with the internal clock. Timings on the bus are determined by the rise and fall times of signals affected by the bus load capacitance, series resistance, and parallel resistance.

Table 16.6 I²C Bus Timing (SCL and SDA Output)

| Item | Symbol | Output Timing | Unit | Notes |
|--|-------------|--|------|-----------------------------|
| SCL output cycle time | t_{SCLO} | $28t_{cyc}$ to $256t_{cyc}$ | ns | Figure 25.26 (reference) |
| SCL output high pulse width | t_{SCLHO} | $0.5t_{SCLO}$ | ns | |
| SCL output low pulse width | t_{SCLLO} | $0.5t_{SCLO}$ | ns | |
| SDA output bus free time | t_{BUFO} | $0.5t_{SCLO} - 1t_{cyc}$ | ns | |
| Start condition output hold time | t_{STAHO} | $0.5t_{SCLO} - 1t_{cyc}$ | ns | |
| Retransmission start condition output setup time | t_{STASO} | $1t_{SCLO}$ | ns | |
| Stop condition output setup time | t_{STOSO} | $0.5t_{SCLO} + 2t_{cyc}$ | ns | |
| Data output setup time (master) | t_{SDASO} | $1t_{SCLLO} - 3t_{cyc}$ | ns | |
| Data output setup time (slave) | | $1t_{SCLL} - (6t_{cyc} \text{ or } 12t_{cyc}^*)$ | | |
| Data output hold time | t_{SDAHO} | $3t_{cyc}$ | ns | |

Note: * $6t_{cyc}$ when IICX is 0, $12t_{cyc}$ when 1.

- SCL and SDA input is sampled in synchronization with the internal clock. The AC timing therefore depends on the system clock cycle t_{cyc} , as shown in I²C bus Timing in section 25, Electrical Characteristics. Note that the I²C bus interface AC timing specifications will not be met with a system clock frequency of less than 5 MHz.
- The I²C bus interface specification for the SCL rise time t_{sr} is under 1000 ns (300 ns for high-speed mode). In master mode, the I²C bus interface monitors the SCL line and synchronizes one bit at a time during communication. If t_{sr} (the time for SCL to go from low to V_{IH}) exceeds the time determined by the input clock of the I²C bus interface, the high period of SCL is extended. The SCL rise time is determined by the pull-up resistance and load capacitance of the SCL line. To insure proper operation at the set transfer rate, adjust the pull-up resistance and load capacitance so that the SCL rise time does not exceed the values given in the table below.

Table 16.7 Permissible SCL Rise Time (t_{sr}) Values

| IICX | t_{cyc} Indication | | I ² C Bus Specification (Max.) | Time Indication | | | | |
|------|-------------------------|-----------------|---|-------------------|-------------------|--------------------|--------------------|--------------------|
| | | | | $\phi =$ 5 MHz | $\phi =$ 8 MHz | $\phi =$ 10 MHz | $\phi =$ 16 MHz | $\phi =$ 20 MHz |
| 0 | $7.5t_{cyc}$ | Normal mode | 1000 ns | 1000 ns | 937 ns | 750 ns | 468 ns | 375 ns |
| | | High-speed mode | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns |
| 1 | $17.5t_{cyc}$ | Normal mode | 1000 ns | 1000 ns | 1000 ns | 1000 ns | 1000 ns | 875 ns |
| | | High-speed mode | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns |

- The I²C bus interface specifications for the SCL and SDA rise and fall times are under 1000 ns and 300 ns. The I²C bus interface SCL and SDA output timing is prescribed by t_{cyc} , as shown in table 16.6. However, because of the rise and fall times, the I²C bus interface specifications may not be satisfied at the maximum transfer rate. Table 16.8 shows output timing calculations for different operating frequencies, including the worst-case influence of rise and fall times.

t_{BUFO} fails to meet the I²C bus interface specifications at any frequency. The solution is either (a) to provide coding to secure the necessary interval (approximately 1 μ s) between issuance of a stop condition and issuance of a start condition, or (b) to select devices whose input timing permits this output timing for use as slave devices connected to the I²C bus.

t_{SCLLO} in high-speed mode and t_{STASO} in standard mode fail to satisfy the I²C bus interface specifications for worst-case calculations of t_{sr}/t_{sr} . Possible solutions that should be investigated include (a) adjusting the rise and fall times by means of a pull-up resistor and capacitive load, (b) reducing the transfer rate to meet the specifications, or (c) selecting devices whose input timing permits this output timing for use as slave devices connected to the I²C bus.

Table 16.8 I²C Bus Timing (with Maximum Influence of t_{Sr}/t_{Sr})

| Item | t_{cyc} Indication | | Time Indication (at Maximum Transfer Rate) [ns] | | | | | | |
|-------------------------|---|-----------------|---|--|---------------------|--------------------|--------------------|--------------------|--------------------|
| | | | t_{Sr}/t_{Sr} Influence (Max.) | I ² C Bus Specifi- cation (Min.) | $\phi =$ 5 MHz | $\phi =$ 8 MHz | $\phi =$ 10 MHz | $\phi =$ 16 MHz | $\phi =$ 20 MHz |
| t_{SCLHO} | $0.5t_{SCLO}$ ($-t_{Sr}$) | Standard mode | -1000 | 4000 | 4000 | 4000 | 4000 | 4000 | 4000 |
| | | High-speed mode | -300 | 600 | 950 | 950 | 950 | 950 | 950 |
| t_{SCLLO} | $0.5t_{SCLO}$ ($-t_{Sr}$) | Standard mode | -250 | 4700 | 4750 | 4750 | 4750 | 4750 | 4750 |
| | | High-speed mode | -250 | 1300 | 1000 ^{*1} | 1000 ^{*1} | 1000 ^{*1} | 1000 ^{*1} | 1000 ^{*1} |
| t_{BUFO} | $0.5t_{SCLO} -$ $1t_{cyc}$ ($-t_{Sr}$) | Standard mode | -1000 | 4700 | 3800 ^{*1} | 3875 ^{*1} | 3900 ^{*1} | 3938 ^{*1} | 3950 ^{*1} |
| | | High-speed mode | -300 | 1300 | 750 ^{*1} | 825 ^{*1} | 850 ^{*1} | 888 ^{*1} | 900 ^{*1} |
| t_{STAHO} | $0.5t_{SCLO} -$ $1t_{cyc}$ ($-t_{Sr}$) | Standard mode | -250 | 4000 | 4550 | 4625 | 4650 | 4688 | 4700 |
| | | High-speed mode | -250 | 600 | 800 | 875 | 900 | 938 | 950 |
| t_{STASO} | $1t_{SCLO}$ ($-t_{Sr}$) | Standard mode | -1000 | 4700 | 9000 | 9000 | 9000 | 9000 | 9000 |
| | | High-speed mode | -300 | 600 | 2200 | 2200 | 2200 | 2200 | 2200 |
| t_{STOSO} | $0.5t_{SCLO} +$ $2t_{cyc}$ ($-t_{Sr}$) | Standard mode | -1000 | 4000 | 4400 | 4250 | 4200 | 4125 | 4100 |
| | | High-speed mode | -300 | 600 | 1350 | 1200 | 1150 | 1075 | 1050 |
| t_{SDASO} (master) | $1t_{SCLLO}$ ^{*3} - $3t_{cyc}$ ($-t_{Sr}$) | Standard mode | -1000 | 250 | 3100 | 3325 | 3400 | 3513 | 3550 |
| | | High-speed mode | -300 | 100 | 400 | 625 | 700 | 813 | 850 |
| t_{SDASO} (slave) | $1t_{SCLL}$ ^{*3} - $12t_{cyc}$ ^{*2} ($-t_{Sr}$) | Standard mode | -1000 | 250 | 1300 | 2200 | 2500 | 2950 | 3100 |
| | | High-speed mode | -300 | 100 | -1400 ^{*1} | -500 ^{*1} | -200 ^{*1} | 250 | 400 |

| | | Time Indication (at Maximum Transfer Rate) [ns] | | | | | | | |
|--------------------|--------------------------------|---|---|--|-------|-------|--------|--------|--------|
| Item | t _{cyc} Indication | | t _{Sr} /t _{Sf} Influence (Max.) | I ² C Bus Specifi- cation (Min.) | φ = | φ = | φ = | φ = | φ = |
| | | | | | 5 MHz | 8 MHz | 10 MHz | 16 MHz | 20 MHz |
| t _{SDAHO} | 3t _{cyc} | Standard mode | 0 | 0 | 600 | 375 | 300 | 188 | 150 |
| | | High-speed mode | 0 | 0 | 600 | 375 | 300 | 188 | 150 |

Notes: 1. Does not meet the I²C bus interface specification. Remedial action such as the following is necessary: (a) secure a start/stop condition issuance interval; (b) adjust the rise and fall times by means of a pull-up resistor and capacitive load; (c) reduce the transfer rate; (d) select slave devices whose input timing permits this output timing.

The values in the above table will vary depending on the settings of the IICX bit and bits CKS0 to CKS2. Depending on the frequency it may not be possible to achieve the maximum transfer rate; therefore, whether or not the I²C bus interface specifications are met must be determined in accordance with the actual setting conditions.

- Value when the IICX bit is set to 1. When the IICX bit is cleared to 0, the value is (t_{SCLL} – 6t_{cyc}).
- Calculated using the I²C bus specification values (standard mode: 4700 ns min.; high-speed mode: 1300 ns min.).

- Note on ICDR Read at End of Master Reception

To halt reception at the end of a receive operation in master receive mode, set the TRS bit to 1 and write 0 to BBSY and SCP in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition. After this, receive data can be read by means of an ICDR read, but if data remains in the buffer the ICDRS receive data will not be transferred to ICDR, and so it will not be possible to read the second byte of data.

If it is necessary to read the second byte of data, issue the stop condition in master receive mode (i.e. with the TRS bit cleared to 0). When reading the receive data, first confirm that the BBSY bit in the ICCR register is cleared to 0, the stop condition has been generated, and the bus has been released, then read the ICDR register with TRS cleared to 0.

Note that if the receive data (ICDR data) is read in the interval between execution of the instruction for issuance of the stop condition (writing of 0 to BBSY and SCP in ICCR) and the actual generation of the stop condition, the clock may not be output correctly in subsequent master transmission.

Clearing of the MST bit after completion of master transmission/reception, or other modifications of IIC control bits to change the transmit/receive operating mode or settings, must be carried out during interval (a) in figure 16.18 (after confirming that the BBSY bit has been cleared to 0 in the ICCR register).

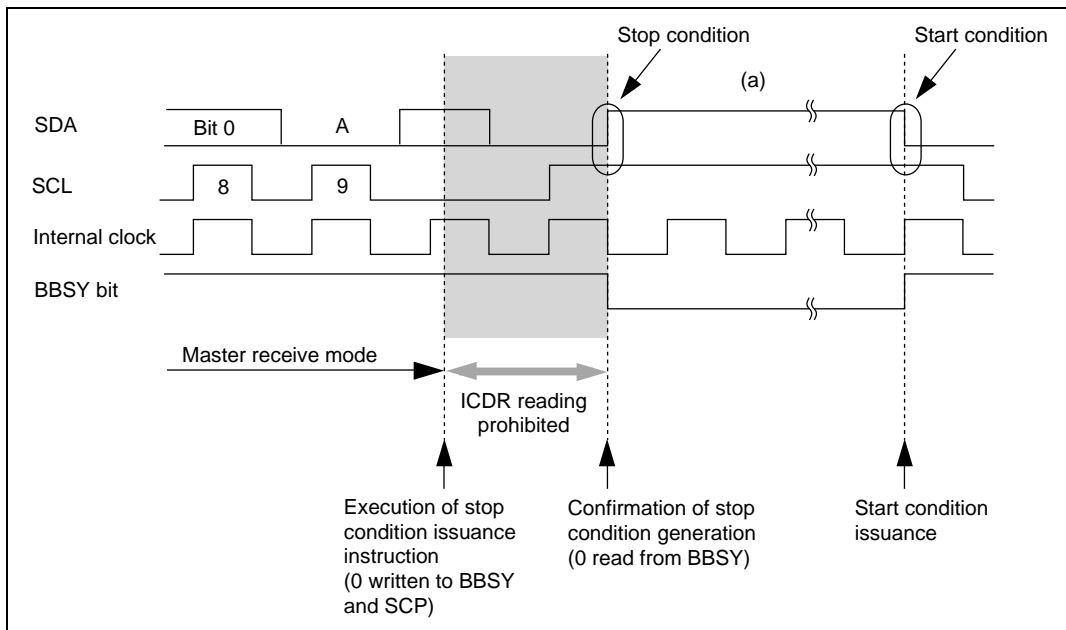


Figure 16.18 Points for Attention Concerning Reading of Master Receive Data

- Notes on Start Condition Issuance for Retransmission

Figure 16.19 shows the timing of start condition issuance for retransmission, and the timing for subsequently writing data to ICDR, together with the corresponding flowchart. After retransmission start condition issuance is done and determined the start condition, write the transmit data to ICDR, as shown below.

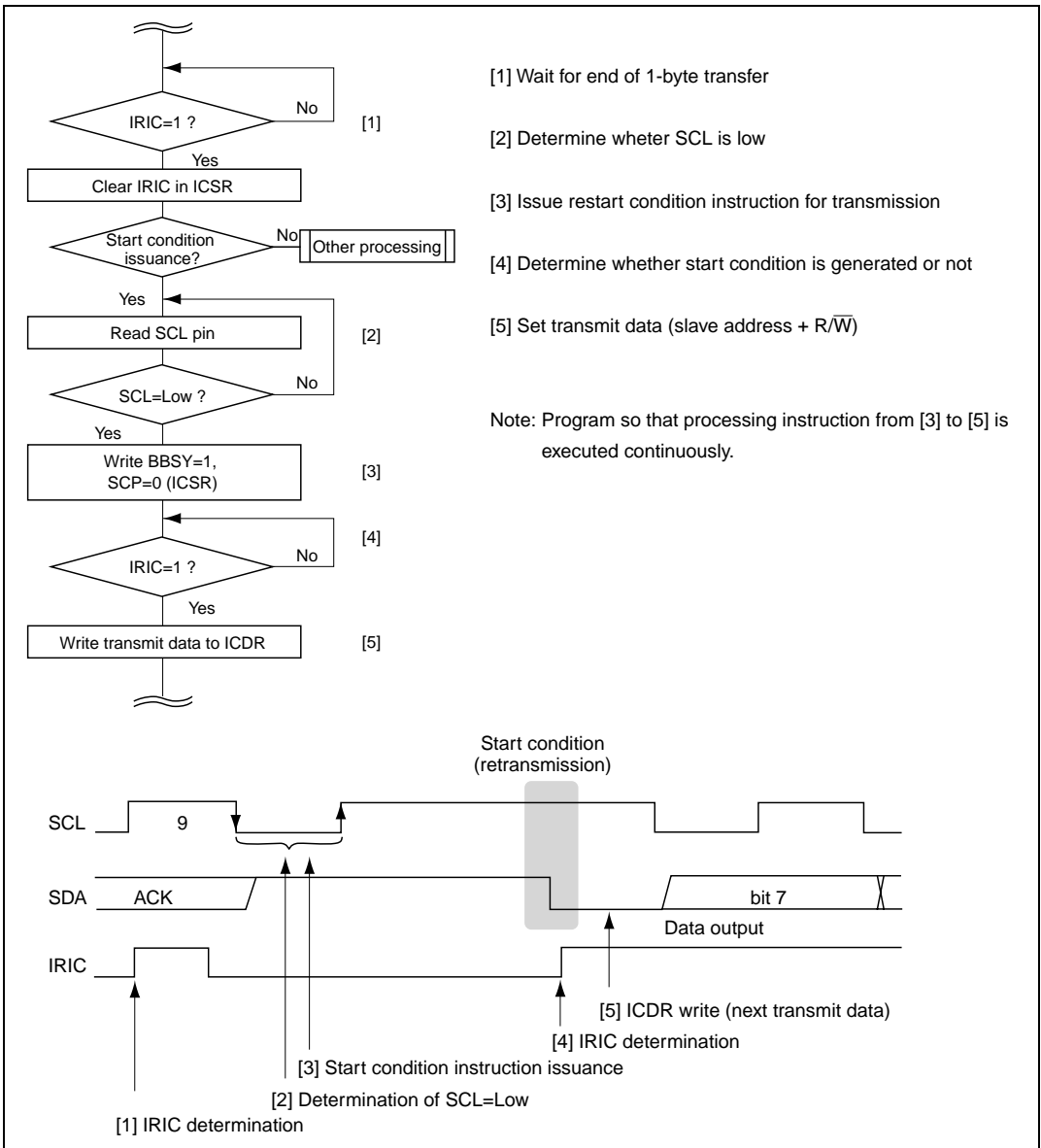


Figure 16.19 Flowchart and Timing of Start Condition Instruction Issuance for Retransmission

- Note on I²C Bus Interface Stop Condition Instruction Issuance

If the rise time of the 9th SCL clock exceeds the specification because the bus load capacitance is large, or if there is a slave devices of the type that drives SCL low to effect a wait, after rising of the 9th SCL clock, issue the stop condition after reading SCL and determining it to be low, as shown below.

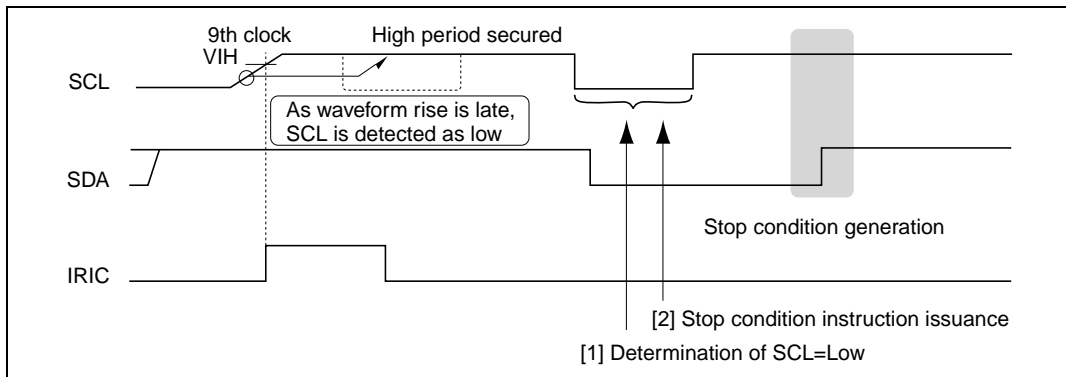


Figure 16.20 Timing of Stop Condition Issuance

- Notes on WAIT Function

- Conditions to cause this phenomenon

When both of the following conditions are satisfied, the clock pulse of the 9th clock could be outputted continuously in master mode using the WAIT function due to the failure of the WAIT insertion after the 8th clock fall.

- (1) Setting the WAIT bit of the ICMR register to 1 and operating WAIT, in master mode
- (2) If the IRIC bit of interrupt flag is cleared from 1 to 0 between the fall of the 7th clock and the fall of the 8th clock.

- Error phenomenon

Normally, WAIT State will be cancelled by clearing the IRIC flag bit from 1 to 0 after the fall of the 8th clock in WAIT State. In this case, if the IRIC flag bit is cleared between the 7th clock fall and the 8th clock fall, the IRIC flag clear- data will be retained internally. Therefore, the WAIT State will be cancelled right after WAIT insertion on 8th clock fall.

- Restrictions

Please clear the IRIC flag before the rise of the 7th clock (the counter value of BC2 through BC0 should be 2 or greater), after the IRIC flag is set to 1 on the rise of the 9th clock.

If the IRIC flag-clear is delayed due to the interrupt or other processes and the value of BC counter is turned to 1 or 0, please confirm the SCL pins are in L' state after the counter value of BC2 through BC0 is turned to 0, and clear the IRIC flag. (See figure 16.21.)

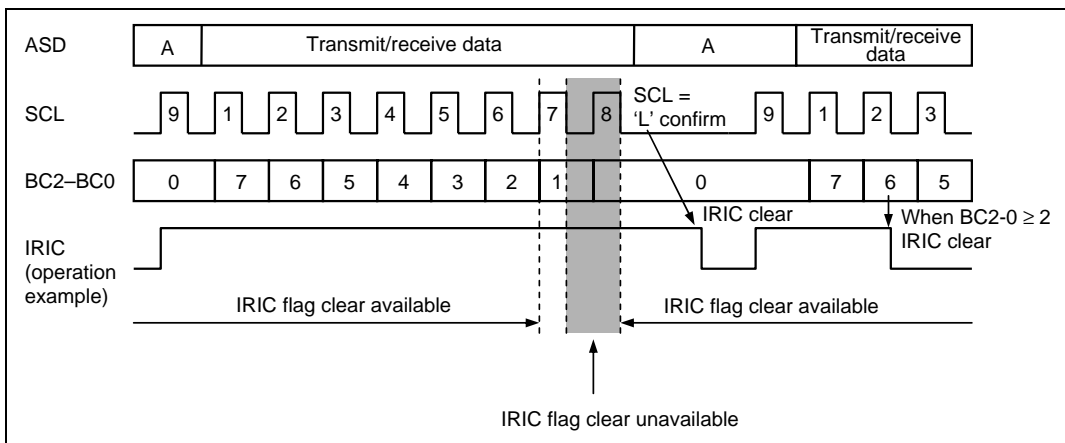


Figure 16.21 IRIC Flag Clear Timing on WAIT Operation

- Notes on ICDR Reads and ICCR Access in Slave Transmit Mode

In a transmit operation in the slave mode of the I²C bus interface, do not read the ICDR register or read or write to the ICCR register during the period indicated by the shaded portion in figure 16.22.

Normally, when interrupt processing is triggered in synchronization with the rising edge of the 9th clock cycle, the period in question has already elapsed when the transition to interrupt processing takes place, so there is no problem with reading the ICDR register or reading or writing to the ICCR register.

To ensure that the interrupt processing is performed properly, one of the following two conditions should be applied.

- (1) Make sure that reading received data from the ICDR register, or reading or writing to the ICCR register, is completed before the next slave address receive operation starts.
- (2) Monitor the BC2 to BC0 counter in the ICMR register and, when the value of BC2 to BC0 is 000 (8th or 9th clock cycle), allow a waiting time of at least 2 transfer clock cycles in order to involve the problem period in question before reading from the ICDR register, or reading or writing to the ICCR register.

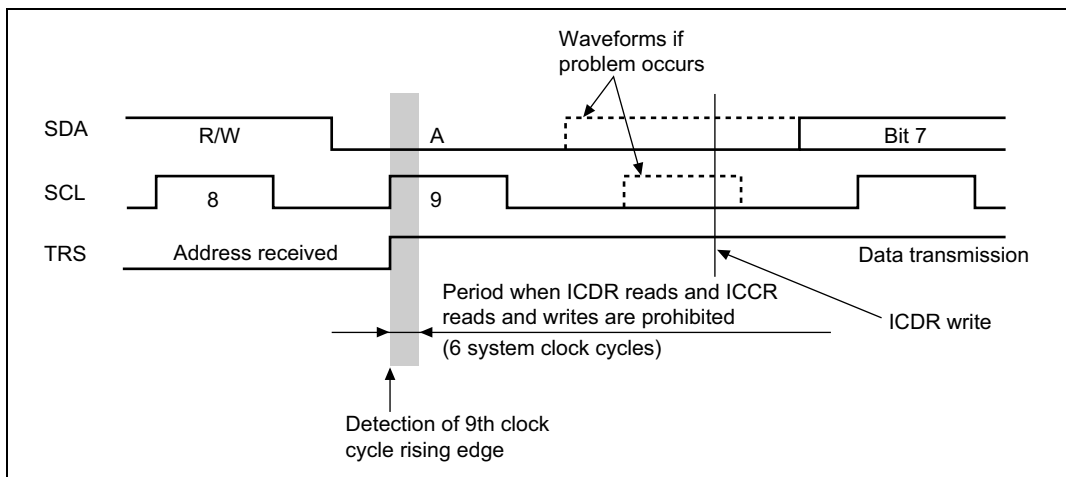


Figure 16.22 ICDR Read and ICCR Access Timing in Slave Transmit Mode

- Notes on TRS Bit Setting in Slave Mode

From the detection of the rising edge of the 9th clock cycle or of a stop condition to when the rising edge of the next SCL pin signal is detected (the period indicated as (a) in figure 16.23) in the slave mode of the I²C bus interface, the value set in the TRS bit in the ICCR register is effective immediately.

However, at other times (indicated as (b) in figure 16.23) the value set in the TRS bit is put on hold until the next rising edge of the 9th clock cycle or stop condition is detected, rather than taking effect immediately.

This results in the actual internal value of the TRS bit remaining 1 (transmit mode) and no acknowledge bit being sent at the 9th clock cycle address receive completion in the case of an address receive operation following a restart condition input with no stop condition intervening.

When receiving an address in the slave mode, clear the TRS bit to 0 during the period indicated as (a) in figure 16.23.

To cancel the holding of the SCL bit low by the wait function in the slave mode, clear the TRS bit to 0 and then perform a dummy read of the ICDR register.

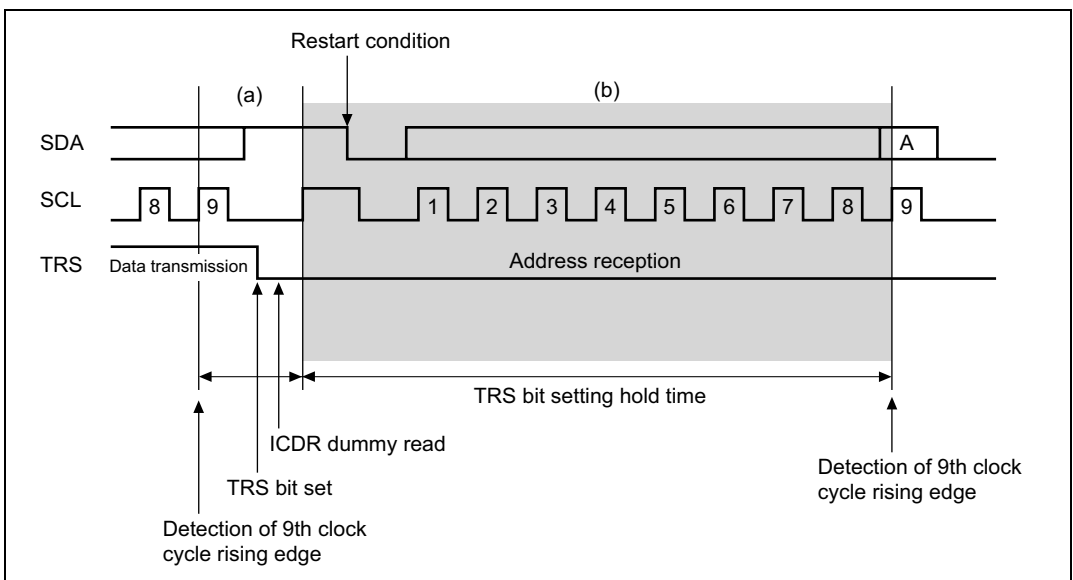


Figure 16.23 TRS Bit Setting Timing in Slave Mode

- Notes on Arbitration Lost in Master Mode

The I²C bus interface recognizes the data in transmit/receive frame as an address when arbitration is lost in master mode and a transition to slave receive mode is automatically carried out.

When arbitration is lost not in the first frame but in the second frame or subsequent frame, transmit/receive data that is not an address is compared with the value set in the SAR or SARX register as an address. If the receive data matches with the address in the SAR or SARX register, the I²C bus interface erroneously recognizes that the address call has occurred. (See figure 16.24.)

In multi-master mode, a bus conflict could happen. When The I²C bus interface is operated in master mode, check the state of the AL bit in the ICSR register every time after one frame of data has been transmitted or received.

When arbitration is lost during transmitting the second frame or subsequent frame, take avoidance measures.

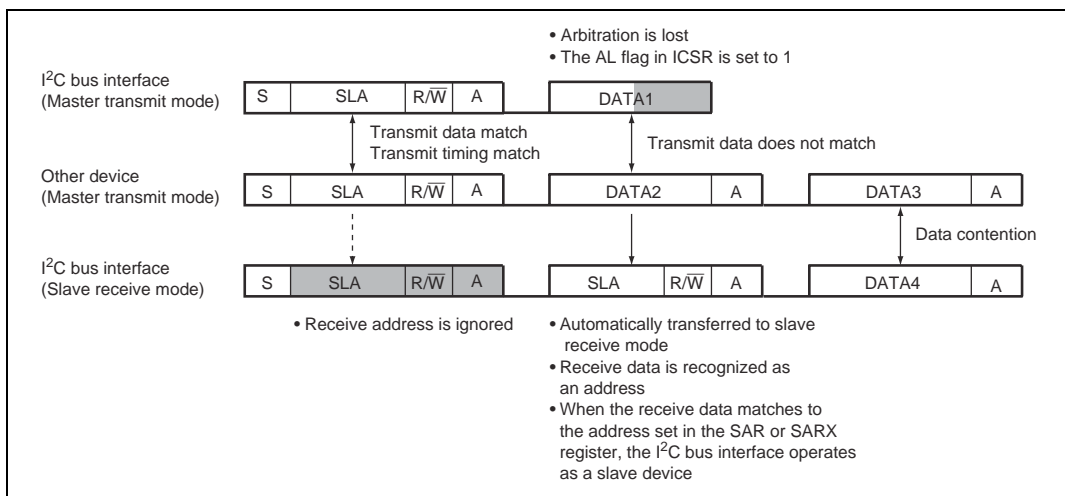


Figure 16.24 Diagram of Erroneous Operation when Arbitration is Lost

Though it is prohibited in the normal I²C protocol, the same problem may occur when the MST bit is erroneously set to 1 and a transition to master mode is occurred during data transmission or reception in slave mode. In multi-master mode, pay attention to the setting of the MST bit when a bus conflict may occur. In this case, the MST bit in the ICCR register should be set to 1 according to the order below.

- Make sure that the BBSY flag in the ICCR register is 0 and the bus is free before setting the MST bit.
- Set the MST bit to 1.

(c) To confirm that the bus was not entered to the busy state while the MST bit is being set, check that the BBSY flag in the ICCR register is 0 immediately after the MST bit has been set.

- Notes on Interrupt Occurrence after ACKB Reception

— Conditions to cause this failure

The IRIC flag is set to 1 when both of the following conditions are satisfied.

- 1 is received as the acknowledge bit for transmit data and the ACKB bit in ICSR is set to 1
- Rising edge of the 9th transmit/receive clock is input to the SCL pin

When the above two conditions are satisfied in slave receive mode, an unnecessary interrupt occurs.

Figure 16.25 shows the note on interrupt occurrence in slave mode after receiving 1 as the acknowledge bit (ACKB = 1).

(1) For the last transmit data in master transmit mode or slave transmit mode, 1 is received as the acknowledge bit.

If the ACKE bit in ICCR is set to 1 at this time, the ACKB bit in ICSR is set to 1.

(2) After switching to slave receive mode, the start condition is input, and address reception is performed next.

(3) Even if the received address does not match the address set in SAR or SARX, the IRIC flag is set to 1 at the rise of the 9th transmit/receive clock, thus causing an interrupt to occur.

Note that if the slave address matches, an interrupt is to be generated at the rise of the 9th transmit/receive clock as normal operation, so this is not erroneous operation.

— Restriction

In a transmit operation of the I²C bus interface module, carry out the following countermeasures.

- (1) After 1 is received as the acknowledge bit for transmit data, clear the ACKE bit in ICCR to 0 to clear the ACKB bit to 0.
- (2) To enable acknowledge bit reception afterwards, set the ACKE bit to 1 again.

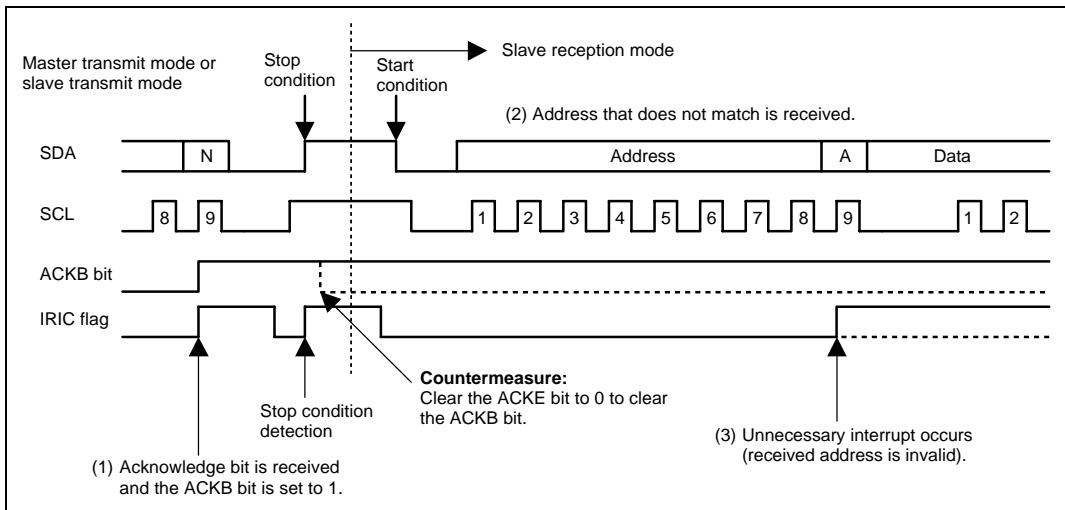


Figure 16.25 Note on Interrupt Occurrence in Slave Mode after ACKB = 1 Reception

- Notes on TRS Bit Setting and ICDR Register Access

Conditions to cause this failure

Low-fixation of the SCL pins is cancelled incorrectly when the following conditions are satisfied.

— Master mode

Figure 16.26 shows the notes on ICDR reading (TRS = 1) in master mode.

- (1) When previously received 2-bytes data remains in ICDR unread (ICDRS are full).
- (2) Reads ICDR register after switching to transmit mode (TRS = 1). (RDRF = 0 state)
- (3) Sets to receive mode (TRS = 0), after transmitting Rev.1 frame of issued start condition by master mode.

— Slave mode

Figure 16.27 shows the notes on ICDR writing (TRS = 0) in slave mode.

- (1) Writes ICDR register in receive mode (TRS = 0), after entering the start condition by slave mode (TDRE = 0 state).

Address match with Rev.1 frame, receive 1 by R/W bit, and switches to transmit mode (TRS = 1).

When these conditions are satisfied, the low fixation of the SCL pins is cancelled without ICDR register access after Rev.1 frame is transferred.

- Restriction

Please carry out the following countermeasures when transmitting/receiving via the IIC bus interface module.

- (1) Please read the ICDR registers in receive mode, and write them in transmit mode.
- (2) In receiving operation with master mode, please issue the start condition after clearing the internal flag of the IIC bus interface module, using CLR3 to CLR0 bit of the DDSCSWR register on bus-free state (BBSY = 0).

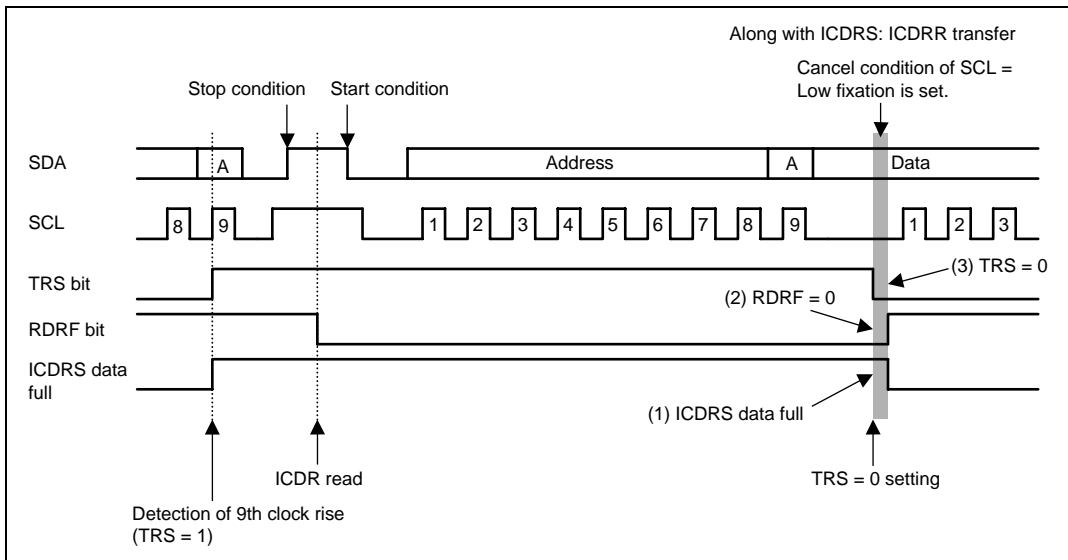


Figure 16.26 Notes on ICDR Reading with TRS = 1 Setting in Master Mode

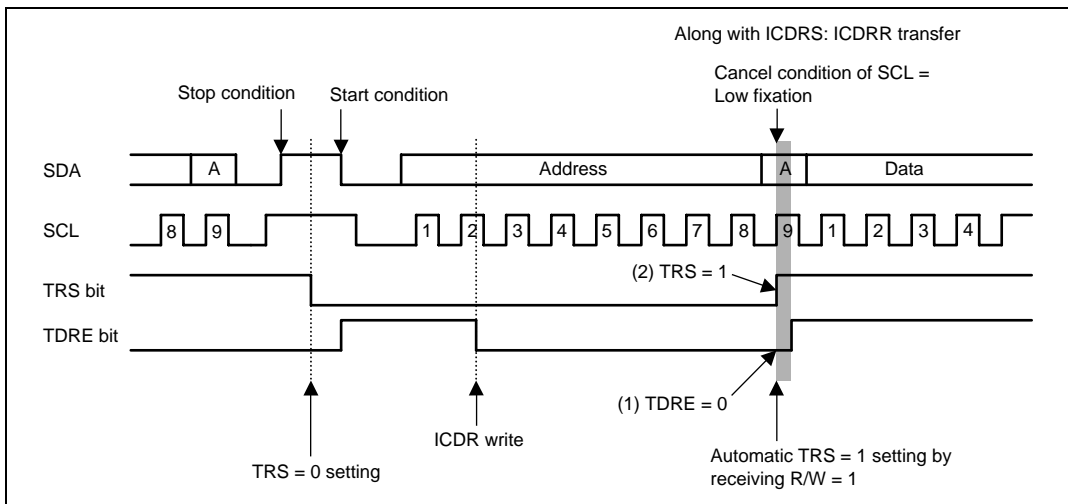


Figure 16.27 Notes on ICDR Writing with TRS = 0 Setting in Slave Mode

Section 17 Host Interface [H8S/2138 Group]

Provided in the H8S/2138 Group; not provided in the H8S/2134 Group.

17.1 Overview

The H8S/2138 Group has an on-chip host interface (HIF) that enables connection to an ISA bus, widely used as the internal bus in personal computers. The host interface provides a dual-channel parallel interface between the on-chip CPU and a host processor. The host interface is available only when the HI12E bit is set to 1 in SYSCR2. This mode is called slave mode, because it is designed for a master-slave communication system in which the H8S/2138 Group chip is slaved to a host processor.

17.1.1 Features

The features of the host interface are summarized below.

The host interface consists of 4-byte data registers, 2-byte status registers, a 1-byte control register, fast A20 gate logic, and a host interrupt request circuit. Communication is carried out via five control signals from the host processor ($\overline{CS1}$, $\overline{CS2}$ or $\overline{ECS2}$, HA0, \overline{IOR} , and \overline{IOW}), four output signals to the host processor (GA20, HIRQ1, HIRQ11, and HIRQ12), and an 8-bit bidirectional command/data bus (HDB7 to HDB0). The $\overline{CS1}$ and $\overline{CS2}$ (or $\overline{ECS2}$) signals select one of the two interface channels.

17.1.2 Block Diagram

Figure 17.1 shows a block diagram of the host interface.

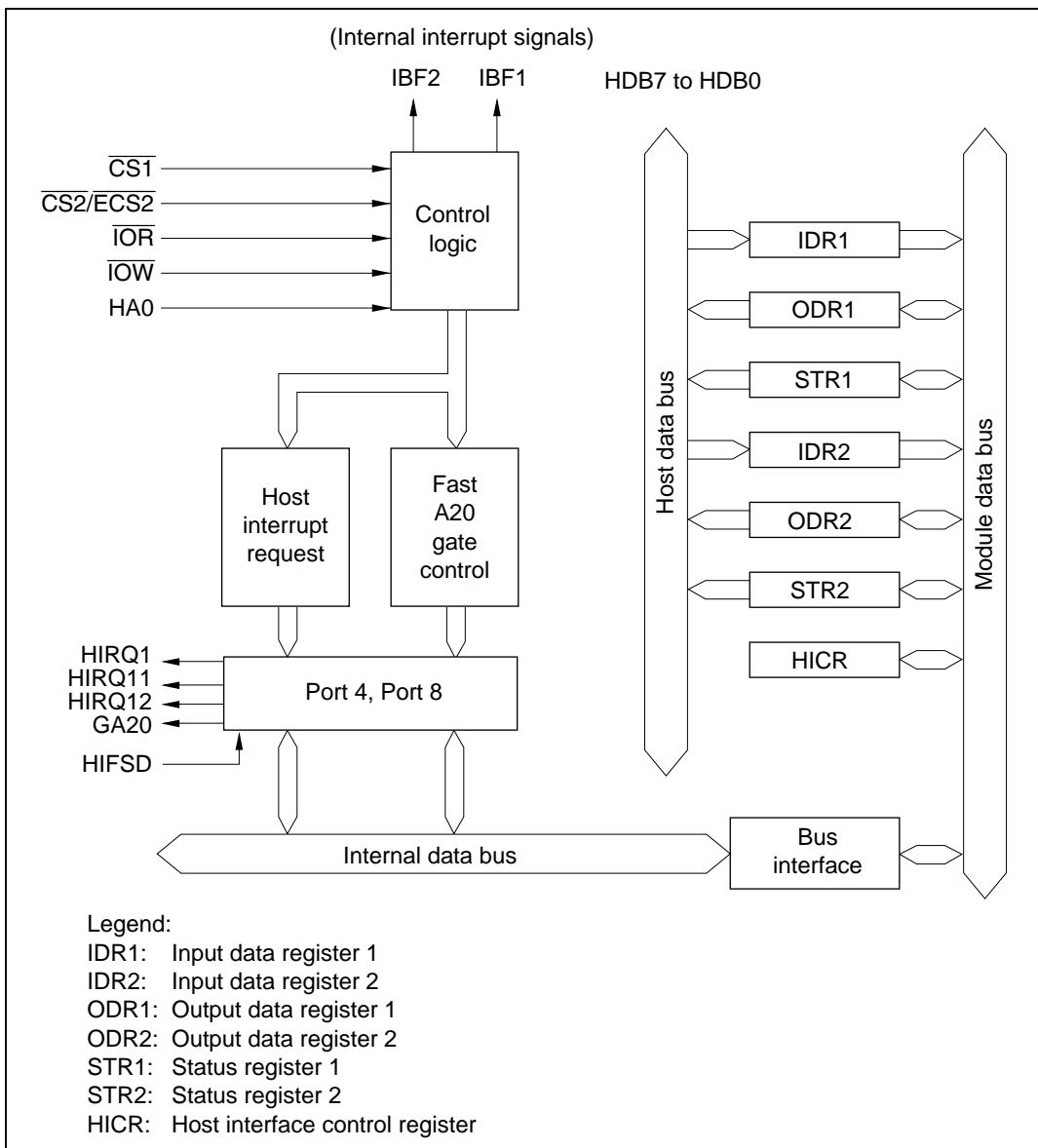


Figure 17.1 Block Diagram of Host Interface

17.1.3 Input and Output Pins

Table 17.1 lists the input and output pins of the host interface module.

Table 17.1 Host Interface Input/Output Pins

| Name | Abbreviation | Port | I/O | Function |
|-------------------|--------------------------|------------|--------|---|
| I/O read | $\overline{\text{IOR}}$ | P93 | Input | Host interface read signal |
| I/O write | $\overline{\text{IOW}}$ | P94 | Input | Host interface write signal |
| Chip select 1 | $\overline{\text{CS1}}$ | P95 | Input | Host interface chip select signal for IDR1, ODR1, STR1 |
| Chip select 2* | $\overline{\text{CS2}}$ | P81 | Input | Host interface chip select signal for IDR2, ODR2, STR2 |
| | $\overline{\text{ECS2}}$ | P90 | | |
| Command/data | HA0 | P80 | Input | Host interface address select signal. In host read access, this signal selects the status registers (STR1, STR2) or data registers (ODR1, ODR2). In host write access to the data registers (IDR1, IDR2), this signal indicates whether the host is writing a command or data. |
| Data bus | HDB7 to HDB0 | P37 to P30 | I/O | Host interface data bus |
| Host interrupt 1 | HIRQ1 | P44 | Output | Interrupt output 1 to host |
| Host interrupt 11 | HIRQ11 | P43 | Output | Interrupt output 11 to host |
| Host interrupt 12 | HIRQ12 | P45 | Output | Interrupt output 12 to host |
| Gate A20 | GA20 | P81 | Output | A20 gate control signal output |
| HIF shutdown | HIFSD | P82 | Input | Host interface shutdown control signal |

Note: * Selection of $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ is by means of the CS2E bit in SYSCR and the FGA20E bit in HICR. Host interface channel 2 and the $\overline{\text{CS2}}$ pin can be used when CS2E = 1. When CS2E = 1, $\overline{\text{CS2}}$ is used when FGA20E = 0, and $\overline{\text{ECS2}}$ is used when FGA20E = 1. In this manual, both are referred to as $\overline{\text{CS2}}$.

17.1.4 Register Configuration

Table 17.2 lists the host interface registers. Host interface registers HICR, IDR1, IDR2, ODR1, ODR2, STR1, and STR2 can only be accessed when the HIE bit is set to 1 in SYSCR.

Table 17.2 Host Interface Registers

| Name | Abbreviation | R/W | | Initial Value | Slave Address ^{*3} | Master Address ^{*4} | | |
|---------------------------------|--------------|---------------------|------|---------------|-----------------------------|------------------------------|-----|-------------------|
| | | Slave | Host | | | CS1 | CS2 | HA0 |
| System control register | SYSCR | R/W ^{*1} | — | H'09 | H'FFC4 | — | — | — |
| System control register 2 | SYSCR2 | R/W | — | H'00 | H'FF83 | — | — | — |
| Host interface control register | HICR | R/W | — | H'F8 | H'FFF0 | — | — | — |
| Input data register 1 | IDR1 | R | W | — | H'FFF4 | 0 | 1 | 0/1 ^{*5} |
| Output data register 1 | ODR1 | R/W | R | — | H'FFF5 | 0 | 1 | 0 |
| Status register 1 | STR1 | R/(W) ^{*2} | R | H'00 | H'FFF6 | 0 | 1 | 1 |
| Input data register 2 | IDR2 | R | W | — | H'FFFC | 1 | 0 | 0/1 ^{*5} |
| Output data register 2 | ODR2 | R/W | R | — | H'FFFD | 1 | 0 | 0 |
| Status register 2 | STR2 | R/(W) ^{*2} | R | H'00 | H'FFFE | 1 | 0 | 1 |
| Module stop control register | MSTPCRH | R/W | — | H'3F | H'FF86 | — | — | — |
| | MSTPCRL | R/W | — | H'FF | H'FF87 | — | — | — |

- Notes:
1. Bits 5 and 3 are read-only bits.
 2. The user-defined bits (bits 7 to 4 and 2) are read/write accessible from the slave processor.
 3. Address when accessed from the slave processor. The lower 16 bits of the address are shown.
 4. Pin inputs used in access from the host processor.
 5. The HA0 input discriminates between writing of commands and data.

17.2 Register Descriptions

17.2.1 System Control Register (SYSCR)

| | | | | | | | | |
|---------------|------|------|-------|-------|------|-------|-----|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

SYSCR is an 8-bit readable/writable register which controls H8S/2138 Group chip operations. Of the host interface registers, HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2 can only be accessed when the HIE bit is set to 1. The host interface $\overline{CS2}$ and $\overline{ECS2}$ pins are controlled by the CS2E bit in SYSCR and the FGA20E bit in HICR. See section 3.2.2, System Control Register (SYSCR), and section 5.2.1, System Control Register (SYSCR), for information on other SYSCR bits. SYSCR is initialized to H'09 by a reset and in hardware standby mode.

Bit 7—CS2 Enable Bit (CS2E): Used together with the FGA20E bit in HICR to select the pin that performs the $\overline{CS2}$ function.

| SYSCR Bit 7 | HICR Bit 0 | Description |
|----------------|---------------|--|
| 0 | 0 | $\overline{CS2}$ pin function halted ($\overline{CS2}$ fixed high internally) (Initial value) |
| | 1 | |
| 1 | 0 | $\overline{CS2}$ pin function selected for P81/ $\overline{CS2}$ pin |
| | 1 | $\overline{CS2}$ pin function selected for P90/ $\overline{ECS2}$ pin |

Bit 1—Host Interface Enable (HIE): Enables or disables CPU access to the host interface registers. When enabled, the host interface registers (HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2) can be accessed.

| Bit 1 | Description |
|-------|--|
| HIE | |
| 0 | Host interface register (HICR, IDR1, ODR1, STR1, IDR2, ODR2, STR2), CPU access is disabled (Initial value) |
| 1 | Host interface register (HICR, IDR1, ODR1, STR1, IDR2, ODR2, STR2), CPU access is enabled |

17.2.2 System Control Register 2 (SYSCR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|---|-----|------|------|-------|
| | KWUL1 | KWUL0 | P6PUE | — | SDE | CS4E | CS3E | HI12E |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | — | R/W | R/W | R/W | R/W |

SYSCR2 is an 8-bit readable/writable register which controls chip operations. Host interface functions are enabled or disabled by the HI12E bit in SYSCR2. SYSCR2 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Key Wakeup Level 1 and 0 (KWUL1, KWUL0): The port 6 input level can be set and changed by software. For details see section 8, I/O Ports.

Bit 5—Port 6 Input Pull-Up Extra (P6PUE): Controls and selects the current specification for the port 6 MOS input pull-up function connected by means of KMPCR settings. For details see section 8, I/O Ports.

Bit 4—Reserved: Do not write 1 to this bit.

Bit 3—Shutdown Enable (SDE): Enables or disables the host interface pin shutdown function. When this function is enabled, host interface pin functions can be halted, and the pins placed in the high-impedance state, according to the state of the HIFSD pin.

Bit 3

| SDE | Description |
|-----|---|
| 0 | Host interface pin shutdown function disabled (Initial value) |
| 1 | Host interface pin shutdown function enabled |

Bit 2—CS4 Enable (CS4E): Reserved. Do not write 1 to this bit.

Bit 1—CS3 Enable (CS3E): Reserved. Do not write 1 to this bit.

Bit 0—Host Interface Enable Bit (HI12E): Enables or disables host interface functions in single-chip mode. When the host interface functions are enabled, slave mode is entered and processing is performed for data transfer between the slave and host.

Bit 0

| HI12E | Description |
|-------|---|
| 0 | Host interface functions are disabled (Initial value) |
| 1 | Host interface functions are enabled |

17.2.3 Host Interface Control Register (HICR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|---|---|---|---|---|--------|--------|--------|
| | — | — | — | — | — | IBFIE2 | IBFIE1 | FGA20E |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Slave Read/Write | — | — | — | — | — | R/W | R/W | R/W |
| Host Read/Write | — | — | — | — | — | — | — | — |

HICR is an 8-bit readable/writable register which controls host interface interrupts and the fast A20 gate function. HICR is initialized to H'F8 by a reset and in hardware standby mode.

Bits 7 to 3—Reserved: These bits cannot be modified and are always read as 1.

Bit 2—Input Data Register Full Interrupt Enable 2 (IBFIE2): Enables or disables the IBF2 interrupt to the internal CPU.

Bit 2

| IBFIE2 | Description |
|--------|---|
| 0 | Input data register (IDR2) receive complete interrupt is disabled (Initial value) |
| 1 | Input data register (IDR2) receive complete interrupt is enabled |

Bit 1—Input Data Register Full Interrupt Enable 1 (IBFIE1): Enables or disables the IBF1 interrupt to the internal CPU.

Bit 1

| IBFIE1 | Description |
|--------|---|
| 0 | Input data register (IDR1) receive complete interrupt is disabled (Initial value) |
| 1 | Input data register (IDR1) receive complete interrupt is enabled |

Bit 0—Fast Gate A20 Enable (FGA20E): Enables or disables the fast A20 gate function. When the fast A20 gate is disabled, a regular-speed A20 gate signal can be implemented by using firmware to manipulate the P81 output.

Bit 0

| FGA20E | Description |
|--------|--|
| 0 | Fast A20 gate function is disabled (Initial value) |
| 1 | Fast A20 gate function is enabled |

17.2.4 Input Data Register 1 (IDR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|------|------|------|------|------|------|------|------|
| | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Slave Read/Write | R | R | R | R | R | R | R | R |
| Host Read/Write | W | W | W | W | W | W | W | W |

IDR1 is an 8-bit read-only register to the slave processor, and an 8-bit write-only register to the host processor. When $\overline{CS1}$ is low, information on the host data bus is written into IDR1 at the rising edge of \overline{IOW} . The HA0 state is also latched into the C/\overline{D} bit in STR1 to indicate whether the written information is a command or data.

The initial values of IDR1 after a reset and in standby mode are undetermined.

17.2.5 Output Data Register 1 (ODR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|------|------|------|------|------|------|------|------|
| | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Slave Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Host Read/Write | R | R | R | R | R | R | R | R |

ODR1 is an 8-bit readable/writable register to the slave processor, and an 8-bit read-only register to the host processor. The ODR1 contents are output on the host data bus when HA0 is low, $\overline{CS1}$ is low, and \overline{IOR} is low.

The initial values of ODR1 after a reset and in standby mode are undetermined.

17.2.6 Status Register 1 (STR1)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|-----|-----|-----|-----|--------------|-----|-----|--------|
| | DBU | DBU | DBU | DBU | C/ \bar{D} | DBU | IBF | OBF |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Slave Read/Write | R/W | R/W | R/W | R/W | R | R/W | R | R/(W)* |
| Host Read/Write | R | R | R | R | R | R | R | R |

Note: * Only 0 can be written, to clear the flag.

STR1 is an 8-bit register that indicates status information during host interface processing. Bits 3, 1, and 0 are read-only bits to both the host and slave processors.

STR1 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4 and Bit 2—Defined by User (DBU): The user can use these bits as necessary.

Bit 3—Command/Data (C/ \bar{D}): Receives the HA0 input when the host processor writes to IDR1, and indicates whether IDR1 contains data or a command.

Bit 3

| C/ \bar{D} | Description |
|--------------|---|
| 0 | Contents of input data register (IDR1) are data (Initial value) |
| 1 | Contents of input data register (IDR1) are a command |

Bit 1—Input Buffer Full (IBF): Set to 1 when the host processor writes to IDR1. This bit is an internal interrupt source to the slave processor. IBF is cleared to 0 when the slave processor reads IDR1.

The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

Bit 1

| IBF | Description |
|-----|---|
| 0 | [Clearing condition] When the slave processor reads IDR1 (Initial value) |
| 1 | [Setting condition] When the host processor writes to IDR1 |

Bit 0—Output Buffer Full (OBF): Set to 1 when the slave processor writes to ODR1. Cleared to 0 when the host processor reads ODR1.

Bit 0

| OBF | Description |
|-----|--|
| 0 | [Clearing condition] When the host processor reads ODR1 or the slave writes 0 in the OBF bit (Initial value) |
| 1 | [Setting condition] When the slave processor writes to ODR1 |

Table 17.3 shows the conditions for setting and clearing the STR1 flags.

Table 17.3 Set/Clear Timing for STR1 Flags

| Flag | Setting Condition | Clearing Condition |
|-------------|--|--|
| C/\bar{D} | Rising edge of host's write signal (\overline{IOW}) when HA0 is high | Rising edge of host's write signal (\overline{IOW}) when HA0 is low |
| IBF* | Rising edge of host's write signal (\overline{IOW}) when writing to IDR1 | Falling edge of slave's internal read signal (\overline{RD}) when reading IDR1 |
| OBF | Falling edge of slave's internal write signal (\overline{WR}) when writing to ODR1 | Rising edge of host's read signal (\overline{IOR}) when reading ODR1 |

Note: * The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

17.2.7 Input Data Register 2 (IDR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|------|------|------|------|------|------|------|------|
| | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Slave Read/Write | R | R | R | R | R | R | R | R |
| Host Read/Write | W | W | W | W | W | W | W | W |

IDR2 is an 8-bit read-only register to the slave processor, and an 8-bit write-only register to the host processor. When $\overline{CS2}$ is low, information on the host data bus is written into IDR2 at the rising edge of \overline{IOW} . The HA0 state is also latched into the C/\bar{D} bit in STR2 to indicate whether the written information is a command or data.

The initial values of IDR2 after a reset and in standby mode are undetermined.

17.2.8 Output Data Register 2 (ODR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|------|------|------|------|------|------|------|------|
| | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Slave Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Host Read/Write | R | R | R | R | R | R | R | R |

ODR2 is an 8-bit readable/writable register to the slave processor, and an 8-bit read-only register to the host processor. The ODR2 contents are output on the host data bus when HA0 is low, $\overline{CS2}$ is low, and \overline{IOR} is low.

The initial values of ODR2 after a reset and in standby mode are undetermined.

17.2.9 Status Register 2 (STR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|-----|-----|-----|-----|-------------------|-----|-----|--------|
| | DBU | DBU | DBU | DBU | C/ \overline{D} | DBU | IBF | OBF |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Slave Read/Write | R/W | R/W | R/W | R/W | R | R/W | R | R/(W)* |
| Host Read/Write | R | R | R | R | R | R | R | R |

Note: * Only 0 can be written, to clear the flag.

STR2 is an 8-bit register that indicates status information during host interface processing. Bits 3, 1, and 0 are read-only bits to both the host and slave processors.

STR2 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4 and Bit 2—Defined by User (DBU): The user can use these bits as necessary.

Bit 3—Command/Data (C/ \overline{D}): Receives the HA0 input when the host processor writes to IDR2, and indicates whether IDR2 contains data or a command.

Bit 3

| C/ \overline{D} | Description |
|-------------------|---|
| 0 | Contents of input data register (IDR2) are data (Initial value) |
| 1 | Contents of input data register (IDR2) are a command |

Bit 1—Input Buffer Full (IBF): Set to 1 when the host processor writes to IDR2. This bit is an internal interrupt source to the slave processor. IBF is cleared to 0 when the slave processor reads IDR2.

The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

Bit 1

| IBF | Description |
|-----|---|
| 0 | [Clearing condition] When the slave processor reads IDR2 (Initial value) |
| 1 | [Setting condition] When the host processor writes to IDR2 |

Bit 0—Output Buffer Full (OBF): Set to 1 when the slave processor writes to ODR2. Cleared to 0 when the host processor reads ODR2. The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

Bit 0

| OBF | Description |
|-----|---|
| 0 | [Clearing condition] When the host processor reads ODR2 or the slave writes 0 in the OBF bit (Initial value) |
| 1 | [Setting condition] When the slave processor writes to ODR2 |

Table 17.4 shows the conditions for setting and clearing the STR2 flags.

Table 17.4 Set/Clear Timing for STR2 Flags

| Flag | Setting Condition | Clearing Condition |
|------------------|--|--|
| C/\overline{D} | Rising edge of host's write signal (\overline{IOW}) when HA0 is high | Rising edge of host's write signal (\overline{IOW}) when HA0 is low |
| IBF* | Rising edge of host's write signal (\overline{IOW}) when writing to IDR2 | Falling edge of slave's internal read signal (\overline{RD}) when reading IDR2 |
| OBF | Falling edge of slave's internal write signal (\overline{WR}) when writing to ODR2 | Rising edge of host's read signal (\overline{IOR}) when reading ODR2 |

Note: * The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

17.2.10 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|--------|--------|--------|--------|--------|-------|-------|---------|-------|-------|-------|-------|-------|-------|-------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | MSTP15 | MSTP14 | MSTP13 | MSTP12 | MSTP11 | MSTP10 | MSTP9 | MSTP8 | MSTP7 | MSTP6 | MSTP5 | MSTP4 | MSTP3 | MSTP2 | MSTP1 | MSTP0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When the MSTP2 bit is set to 1, the host interface halts and enters module stop mode. See section 24.5, Module Stop Mode, for details.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRL Bit 2—Module Stop (MSTP2): Specifies host interface module stop mode.

MSTPCRL

Bit 2

| MSTP2 | Description |
|-------|--|
| 0 | Host interface module stop mode is cleared |
| 1 | Host interface module stop mode is set (Initial value) |

17.3 Operation

17.3.1 Host Interface Operation

The host interface is activated by setting the HI12E bit (bit 0) to 1 in SYSCR2 in single-chip mode, establishing slave mode. Activation of the host interface (entry to slave mode) appropriates the related I/O lines in port 3 (data), port 8 or 9 (control), and port 4 (host interrupt requests) for interface use.

Table 17.5 shows HIF host interface channel selection and pin operation.

Table 17.5 Host Interface Channel Selection and Pin Operation

| HI12E | CS2E | Operation |
|-------|------|---|
| 0 | — | Host interface functions halted |
| 1 | 0 | Host interface channel 1 only operating Operation of channel 2 halted (No operation as $\overline{CS2}$ or $\overline{ECS2}$ input. Pins P43, P81, and P90 operate as I/O ports.) |
| | 1 | Host interface channel 1 and 2 functions operating |

For host read/write timing, see section 25.6.4, Timing of On-Chip Supporting Modules.

17.3.2 Control States

Table 17.6 indicates the slave operations carried out in response to host interface signals from the host processor.

Table 17.6 Host Interface Operation

| $\overline{CS2}$ | $\overline{CS1}$ | $\overline{I\!O\!R}$ | $\overline{I\!O\!W}$ | HA0 | Operation | | | |
|------------------|------------------|----------------------|----------------------|-----|---|--|---|------------|
| 1 | 0 | 0 | 0 | 0 | Setting prohibited | | | |
| | | | | 1 | Setting prohibited | | | |
| | | | | 1 | 0 | Data read from output data register 1 (ODR1) | | |
| | | | | 1 | Status read from status register 1 (STR1) | | | |
| | | | 1 | 0 | 1 | 0 | Data write to input data register 1 (IDR1) | |
| | | | | | | 1 | Command write to input data register 1 (IDR1) | |
| | | | | | | 1 | 0 | Idle state |
| | | | | | | 1 | Idle state | |
| 0 | 1 | 0 | 0 | 0 | Setting prohibited | | | |
| | | | | 1 | Setting prohibited | | | |
| | | | | 1 | 0 | Data read from output data register 2 (ODR2) | | |
| | | | | 1 | Status read from status register 2 (STR2) | | | |
| | | | 1 | 0 | 1 | 0 | Data write to input data register 2 (IDR2) | |
| | | | | | | 1 | Command write to input data register 2 (IDR2) | |
| | | | | | | 1 | 0 | Idle state |
| | | | | | | 1 | Idle state | |

17.3.3 A20 Gate

The A20 gate signal can mask address A20 to emulate an addressing mode used by personal computers with an 8086*-family CPU. In slave mode, a regular-speed A20 gate signal can be output under firmware control, or a fast A20 gate signal can be output under hardware control. Fast A20 gate output is enabled by setting the FGA20E bit (bit 0) to 1 in HICR (H'FFF0).

Note: * Intel microprocessor.

Regular A20 Gate Operation: Output of the A20 gate signal can be controlled by an H'D1 command followed by data. When the slave processor receives data, it normally uses an interrupt routine activated by the IBF1 interrupt to read IDR1. If the data follows an H'D1 command, software copies bit 1 of the data and outputs it at the gate A20 pin.

Fast A20 Gate Operation: When the FGA20E bit is set to 1, P81/GA20 is used for output of a fast A20 gate signal. Bit P81DDR must be set to 1 to assign this pin for output. The initial output from this pin will be a logic 1, which is the initial value. Afterward, the host processor can manipulate the output from this pin by sending commands and data. This function is available

only when register IDR1 is accessed using $\overline{CS1}$. Slave logic decodes the commands input from the host processor. When an H'D1 host command is detected, bit 1 of the data following the host command is output from the GA20 output pin. This operation does not depend on firmware or interrupts, and is faster than the regular processing using interrupts. Table 17.7 lists the conditions that set and clear GA20 (P81). Figure 17.2 shows the GA20 output in flowchart form. Table 17.8 indicates the GA20 output signal values.

Table 17.7 GA20 (P81) Set/Clear Timing

| Pin Name | Setting Condition | Clearing Condition |
|------------|---|--|
| GA20 (P81) | Rising edge of the host's write signal (\overline{IOW}) when bit 1 of the written data is 1 and the data follows an H'D1 host command | Rising edge of the host's write signal (\overline{IOW}) when bit 1 of the written data is 0 and the data follows an H'D1 host command Also, when bit FGA20E in HICR is cleared to 0 |

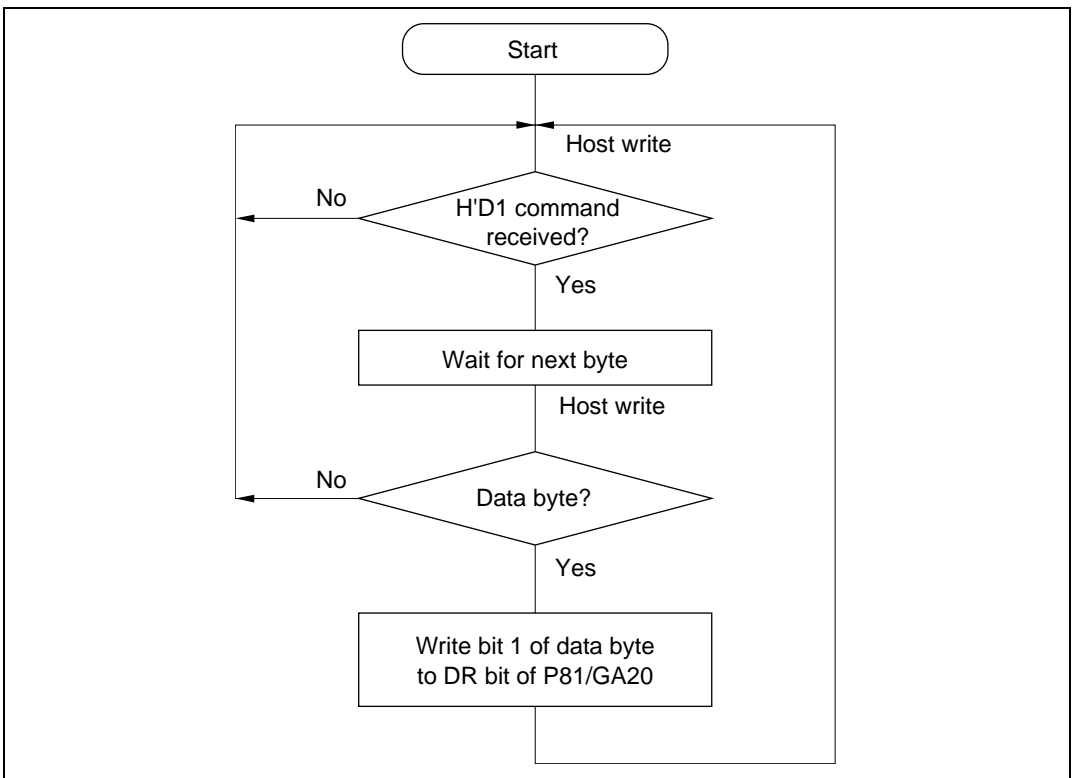


Figure 17.2 GA20 Output

Table 17.8 Fast A20 Gate Output Signals

| HA0 | Data/Command | Internal CPU Interrupt Flag (IBF) | GA20 (P81) | Remarks |
|-----|-------------------------------------|--------------------------------------|---------------|---|
| 1 | H'D1 command | 0 | Q | Turn-on sequence |
| 0 | 1 data* ¹ | 0 | 1 | |
| 1 | H'FF command | 0 | Q (1) | |
| 1 | H'D1 command | 0 | Q | Turn-off sequence |
| 0 | 0 data* ² | 0 | 0 | |
| 1 | H'FF command | 0 | Q (0) | |
| 1 | H'D1 command | 0 | Q | Turn-on sequence (abbreviated form) |
| 0 | 1 data* ¹ | 0 | 1 | |
| 1/0 | Command other than H'FF and H'D1 | 1 | Q (1) | |
| 1 | H'D1 command | 0 | Q | Turn-off sequence (abbreviated form) |
| 0 | 0 data* ² | 0 | 0 | |
| 1/0 | Command other than H'FF and H'D1 | 1 | Q (0) | |
| 1 | H'D1 command | 0 | Q | Cancelled sequence |
| 1 | Command other than H'D1 | 1 | Q | |
| 1 | H'D1 command | 0 | Q | Retriggered sequence |
| 1 | H'D1 command | 0 | Q | |
| 1 | H'D1 command | 0 | Q | Consecutively executed sequences |
| 0 | Any data | 0 | 1/0 | |
| 1 | H'D1 command | 0 | Q(1/0) | |

Notes: 1. Arbitrary data with bit 1 set to 1.
2. Arbitrary data with bit 1 cleared to 0.

17.3.4 Host Interface Pin Shutdown Function

Host interface output can be placed in the high-impedance state according to the state of the HIFSD pin. Setting the SDE bit to 1 in the SYSCR2 register enables the HIFSD pin in slave mode. The HIF constantly monitors the HIFSD pin, and when this pin goes low, places the host interface output pins (HIRQ1, HIRQ11, HIRQ12, and GA20) in the high-impedance state. At the same time, the host interface input pins ($\overline{CS1}$, $\overline{CS2}$ or $\overline{ECS2}$, \overline{IOW} , \overline{IOR} , and HA0) are disabled (fixed at the high input state internally) regardless of the pin states, and the signals of the multiplexed

functions of these pins (input block) are similarly fixed internally. As a result, the host interface I/O pins (HDB7 to HDB0) also go to the high-impedance state.

This state is maintained while the HIFSD pin is low, and when the HIFSD pin returns to the high-level state, the pins are restored to their normal operation as host interface pins.

Table 17.9 shows the scope of HIF pin shutdown in slave mode.

Table 17.9 Scope of HIF Pin Shutdown in Slave Mode

| Abbreviation | Port | Scope of Shutdown in Slave Mode | I/O | Selection Conditions |
|--------------------------|------------|---------------------------------|--------|--|
| $\overline{\text{IOR}}$ | P93 | O | Input | Slave mode |
| $\overline{\text{IOW}}$ | P94 | O | Input | Slave mode |
| $\overline{\text{CS1}}$ | P95 | O | Input | Slave mode |
| $\overline{\text{CS2}}$ | P81 | Δ | Input | Slave mode and CS2E = 1 and FGA20E = 0 |
| $\overline{\text{ECS2}}$ | P90 | Δ | Input | Slave mode and CS2E = 1 and FGA20E = 1 |
| HA0 | P80 | O | Input | Slave mode |
| HDB7 to HDB0 | P37 to P30 | O | I/O | Slave mode |
| HIRQ11 | P43 | Δ | Output | Slave mode and CS2E = 1 and P43DDR = 1 |
| HIRQ1 | P44 | Δ | Output | Slave mode and P44DDR = 1 |
| HIRQ12 | P45 | Δ | Output | Slave mode and P45DDR = 1 |
| GA20 | P81 | Δ | Output | Slave mode and FGA20E = 1 |
| HIFSD | P82 | — | Input | Slave mode and SDE = 1 |

Notes: Slave mode: Single-chip mode and HI12E = 1

O: Pins shut down by shutdown function

The $\overline{\text{IRQ2/ADTRG}}$ input signal is also fixed in the case of P90 shutdown, the $\overline{\text{TMCI1/HSYNCI}}$ signal in the case of P43 shutdown, and the $\overline{\text{TMRI/CSYNCI}}$ in the case of P45 shutdown.

Δ : Pins shut down only when the HIF function is selected by means of a register setting

—: Pin not shut down

17.4 Interrupts

17.4.1 IBF1, IBF2

The host interface can issue two interrupt requests to the slave CPU: IBF1 and IBF2. They are input buffer full interrupts for input data registers IDR1 and IDR2 respectively. Each interrupt is enabled when the corresponding enable bit is set.

Table 17.10 Input Buffer Full Interrupts

| Interrupt | Description |
|-----------|--|
| IBF1 | Requested when IBFIE1 is set to 1 and IDR1 is full |
| IBF2 | Requested when IBFIE2 is set to 1 and IDR2 is full |

17.4.2 HIRQ11, HIRQ1, and HIRQ12

In slave mode (single-chip mode, with HI12E = 1 in SYSCR2), bits P45DR to P43DR in the port 4 data register (P4DR) can be used as host interrupt request latches.

These three P4DR bits are cleared to 0 by the host processor's read signal ($\overline{\text{IOR}}$). If $\overline{\text{CS1}}$ and HA0 are low, when $\overline{\text{IOR}}$ goes low and the host reads ODR1, HIRQ1 and HIRQ12 are cleared to 0. If $\overline{\text{CS2}}$ and HA0 are low, when $\overline{\text{IOR}}$ goes low and the host reads ODR2, HIRQ11 is cleared to 0. To generate a host interrupt request, normally on-chip firmware writes 1 in the corresponding bit. In processing the interrupt, the host's interrupt handling routine reads the output data register (ODR1 or ODR2), and this clears the host interrupt latch to 0.

Table 17.11 indicates how these bits are set and cleared. Figure 17.3 shows the processing in flowchart form.

Table 17.11 HIRQ Setting/Clearing Conditions

| Host Interrupt Signal | Setting Condition | Clearing Condition |
|-----------------------|---|---|
| HIRQ11 (P43) | Slave CPU reads 0 from bit P43DR, then writes 1 | Slave CPU writes 0 in bit P43DR, or host reads output data register 2 |
| HIRQ1 (P44) | Slave CPU reads 0 from bit P44DR, then writes 1 | Slave CPU writes 0 in bit P44DR, or host reads output data register 1 |
| HIRQ12 (P45) | Slave CPU reads 0 from bit P45DR, then writes 1 | Slave CPU writes 0 in bit P45DR, or host reads output data register 1 |

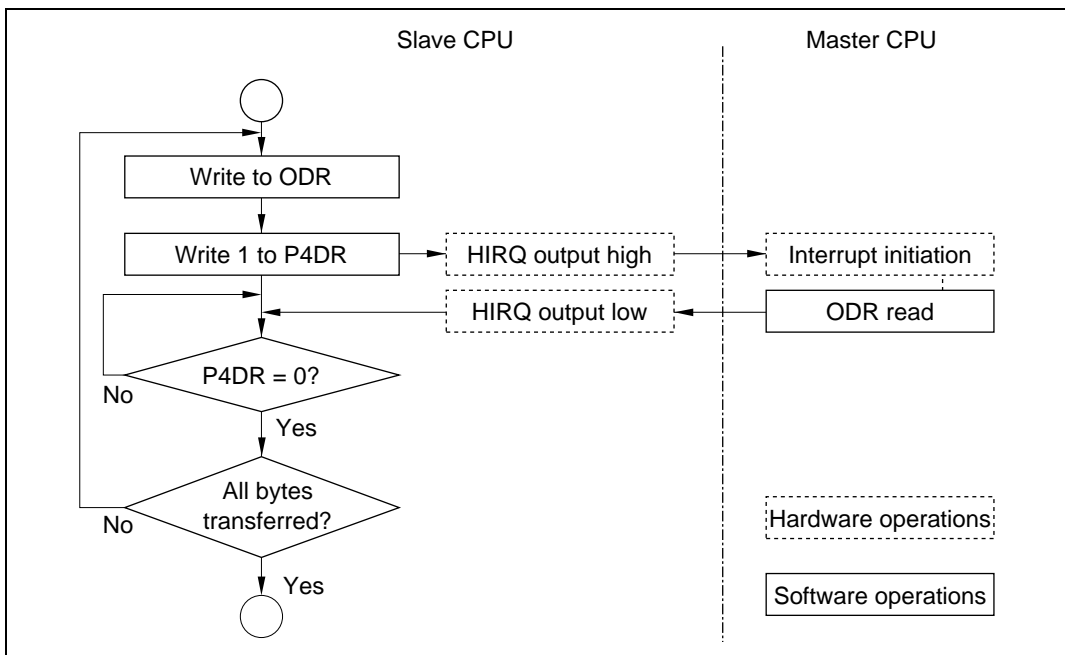


Figure 17.3 HIRQ Output Flowchart

HIRQ Setting/Clearing Contention: If there is contention between a P4DR read/write by the CPU and P4DR (HIRQ11, HIRQ1, HIRQ12) clearing by the host, clearing by the host is held pending during the P4DR read/write by the CPU. P4DR clearing is executed after completion of the read/write.

17.5 Usage Note

The host interface provides buffering of asynchronous data from the host and slave processors, but an interface protocol must be followed to implement necessary functions and avoid data contention. For example, if the host and slave processors try to access the same input or output data register simultaneously, the data will be corrupted. Interrupts can be used to design a simple and effective protocol.

Also, if $\overline{CS1}$ and $\overline{CS2}$ or $\overline{ECS2}$ are driven low simultaneously in attempting IDR or ODR access, signal contention will occur within the chip, and a through-current may result. This usage must therefore be avoided.

Section 18 D/A Converter

18.1 Overview

The H8S/2138 Group and H8S/2134 Group have an on-chip D/A converter module with two channels.

18.1.1 Features

Features of the D/A converter module are listed below.

- Eight-bit resolution
- Two-channel output
- Maximum conversion time: 10 μ s (with 20-pF load capacitance)
- Output voltage: 0 V to AV_{cc}
- D/A output retention in software standby mode

18.1.2 Block Diagram

Figure 18.1 shows a block diagram of the D/A converter.

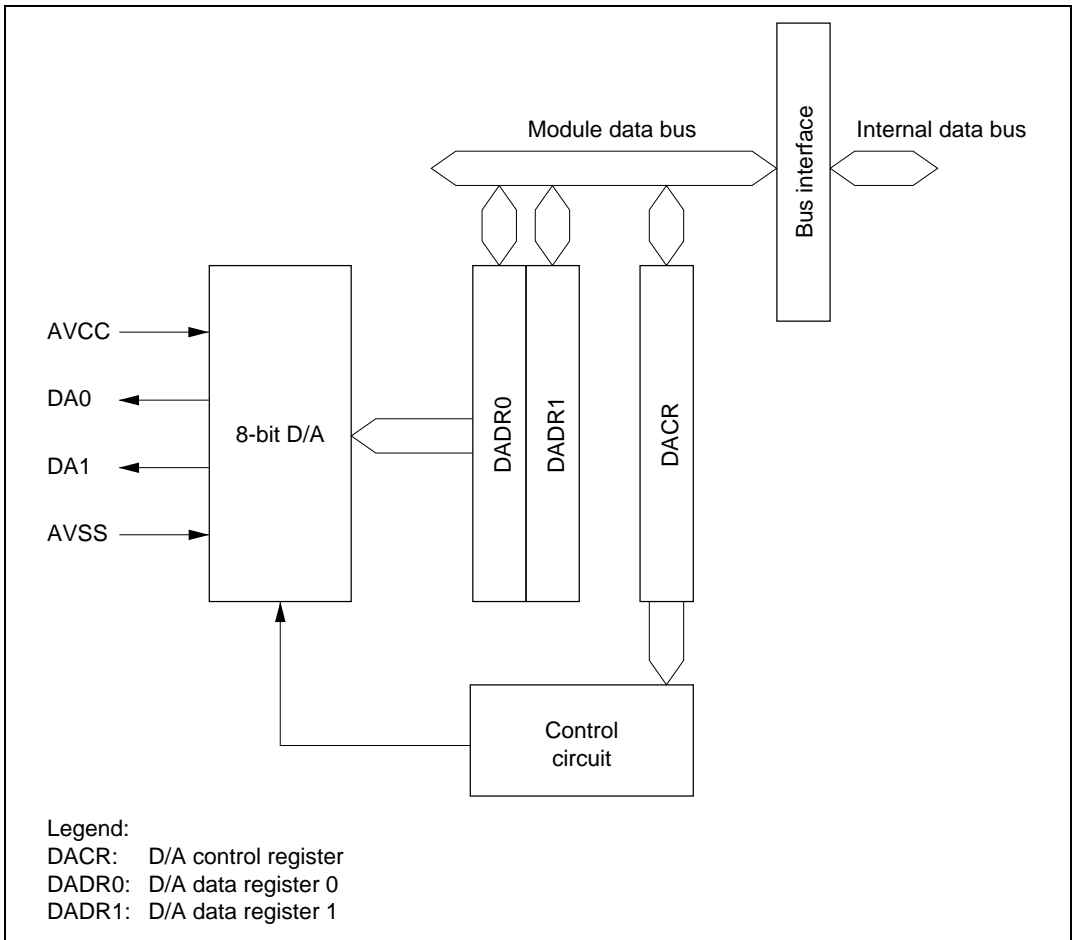


Figure 18.1 Block Diagram of D/A Converter

18.1.3 Input and Output Pins

Table 18.1 lists the input and output pins used by the D/A converter module.

Table 18.1 Input and Output Pins of D/A Converter Module

| Name | Abbreviation | I/O | Function |
|-----------------------|--------------|--------|--|
| Analog supply voltage | AVCC | Input | Power supply for analog circuits |
| Analog ground | AVSS | Input | Ground and reference voltage for analog circuits |
| Analog output 0 | DA0 | Output | Analog output channel 0 |
| Analog output 1 | DA1 | Output | Analog output channel 1 |

18.1.4 Register Configuration

Table 18.2 lists the registers of the D/A converter module.

Table 18.2 D/A Converter Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|------------------------------|--------------|-----|---------------|----------|
| D/A data register 0 | DADR0 | R/W | H'00 | H'FFF8 |
| D/A data register 1 | DADR1 | R/W | H'00 | H'FFF9 |
| D/A control register | DACR | R/W | H'1F | H'FFFA |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | MSTPCRL | R/W | H'FF | H'FF87 |

Note: * Lower 16 bits of the address.

18.2 Register Descriptions

18.2.1 D/A Data Registers 0 and 1 (DADR0, DADR1)

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

D/A data registers 0 and 1 (DADR0 and DADR1) are 8-bit readable/writable registers that store data to be converted. When analog output is enabled, the value in the D/A data register is converted and output continuously at the analog output pin.

The D/A data registers are initialized to H'00 by a reset and in hardware standby mode.

18.2.2 D/A Control Register (DACR)

| | | | | | | | | |
|---------------|-------|-------|-----|---|---|---|---|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | DAOE1 | DAOE0 | DAE | — | — | — | — | — |
| Initial value | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | — | — | — | — | — |

DACR is an 8-bit readable/writable register that controls the operation of the D/A converter module.

DACR is initialized to H'1F by a reset and in hardware standby mode.

Bit 7—D/A Output Enable 1 (DAOE1): Controls D/A conversion and analog output.

Bit 7

| DAOE1 | Description |
|-------|--|
| 0 | Analog output DA1 is disabled (Initial value) |
| 1 | D/A conversion is enabled on channel 1. Analog output DA1 is enabled |

Bit 6—D/A Output Enable 0 (DAOE0): Controls D/A conversion and analog output.

Bit 6

| DAOE0 | Description |
|-------|--|
| 0 | Analog output DA0 is disabled (Initial value) |
| 1 | D/A conversion is enabled on channel 0. Analog output DA0 is enabled |

Bit 5—D/A Enable (DAE): Controls D/A conversion, in combination with bits DAOE0 and DAOE1. D/A conversion is controlled independently on channels 0 and 1 when DAE = 0. Channels 0 and 1 are controlled together when DAE = 1.

Output of the converted results is always controlled independently by DAOE0 and DAOE1.

| Bit 7 DAOE1 | Bit 6 DAOE0 | Bit 5 DAE | D/A conversion |
|----------------|----------------|--------------|---|
| 0 | 0 | * | Disabled on channels 0 and 1 |
| | 1 | 0 | Enabled on channel 0 Disabled on channel 1 |
| | | 1 | Enabled on channels 0 and 1 |
| 1 | 0 | 0 | Disabled on channel 0 Enabled on channel 1 |
| | | 1 | Enabled on channels 0 and 1 |
| | 1 | * | Enabled on channels 0 and 1 |

*: Don't care

If the H8S/2138 Group chip enters software standby mode while D/A conversion is enabled, the D/A output is retained and the analog power supply current is the same as during D/A conversion. If it is necessary to reduce the analog power supply current in software standby mode, disable D/A output by clearing both the DAOE0, DAOE1 and DAE bits to 0.

Bits 4 to 0—Reserved: These bits cannot be modified and are always read as 1.

18.2.3 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|-----|-----|-----|-----|-----|-----|-----|---------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When the MSTP10 bit is set to 1, the D/A converter halts and enters module stop mode at the end of the bus cycle. See section 24.5, Module Stop Mode, for details.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 10—Module Stop (MSTP10): Specifies D/A converter module stop mode.

MSTPCRH

Bit 2

| MSTP10 | Description |
|--------|---|
| 0 | D/A converter module stop mode is cleared |
| 1 | D/A converter module stop mode is set (Initial value) |

18.3 Operation

The D/A converter module has two on-chip D/A converter circuits that can operate independently.

D/A conversion is performed continuously whenever enabled by the D/A control register (DACR). When a new value is written in DADR0 or DADR1, conversion of the new value begins immediately. The converted result is output by setting the DAOE0 or DAOE1 bit to 1.

An example of conversion on channel 0 is given next. Figure 18.2 shows the timing.

- Software writes the data to be converted in DADR0.
- D/A conversion begins when the DAOE0 bit in DACR is set to 1. After the elapse of the conversion time, analog output appears at the DA0 pin. Output of the converted result begins after the conversion time. The output value is $AV_{CC} \times (\text{DADR value})/256$.
- This output continues until a new value is written in DADR0 or the DAOE0 bit is cleared to 0.
- If a new value is written in DADR0, conversion begins immediately. Output of the converted result begins after the conversion time.
- When the DAOE0 bit is cleared to 0, DA0 becomes an input pin.

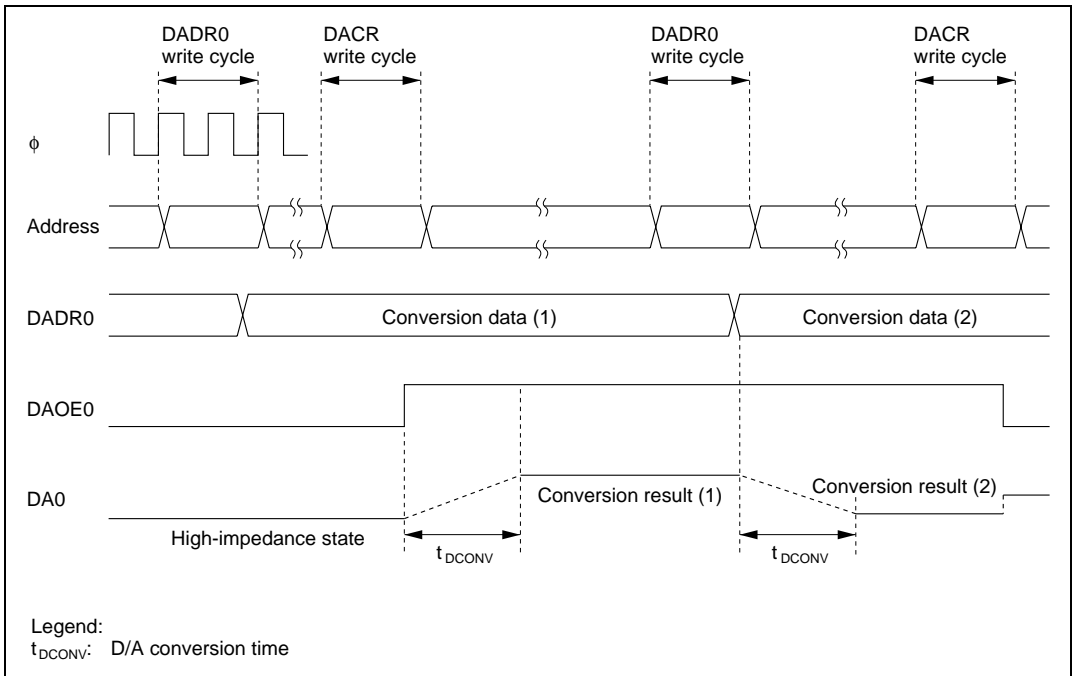


Figure 18.2 D/A Conversion (Example)

Section 19 A/D Converter

19.1 Overview

The H8S/2138 Group and H8S/2134 Group incorporate a 10-bit successive-approximations A/D converter that allows up to eight analog input channels to be selected.

In addition to the eight analog input channels, up to 8 channels of digital input can be selected for A/D conversion. Since the conversion precision falls to the equivalent of 6-bit resolution when digital input is selected, digital input is ideal for use by a comparator identifying multi-valued inputs, for example.

19.1.1 Features

A/D converter features are listed below.

- 10-bit resolution
- Eight (analog) or 8 (digital) input channels
- Settable analog conversion voltage range
 - The analog conversion voltage range is set using the analog power supply voltage pin (AVcc) as the analog reference voltage
- High-speed conversion
 - Minimum conversion time: 6.7 μ s per channel (at 20-MHz operation)
- Choice of single mode or scan mode
 - Single mode: Single-channel A/D conversion
 - Scan mode: Continuous A/D conversion on 1 to 4 channels
- Four data registers
 - Conversion results are held in a 16-bit data register for each channel
- Sample and hold function
- Three kinds of conversion start
 - Choice of software or timer conversion start trigger (8-bit timer), or $\overline{\text{ADTRG}}$ pin
- A/D conversion end interrupt generation
 - An A/D conversion end interrupt (ADI) request can be generated at the end of A/D conversion

19.1.2 Block Diagram

Figure 19.1 shows a block diagram of the A/D converter.

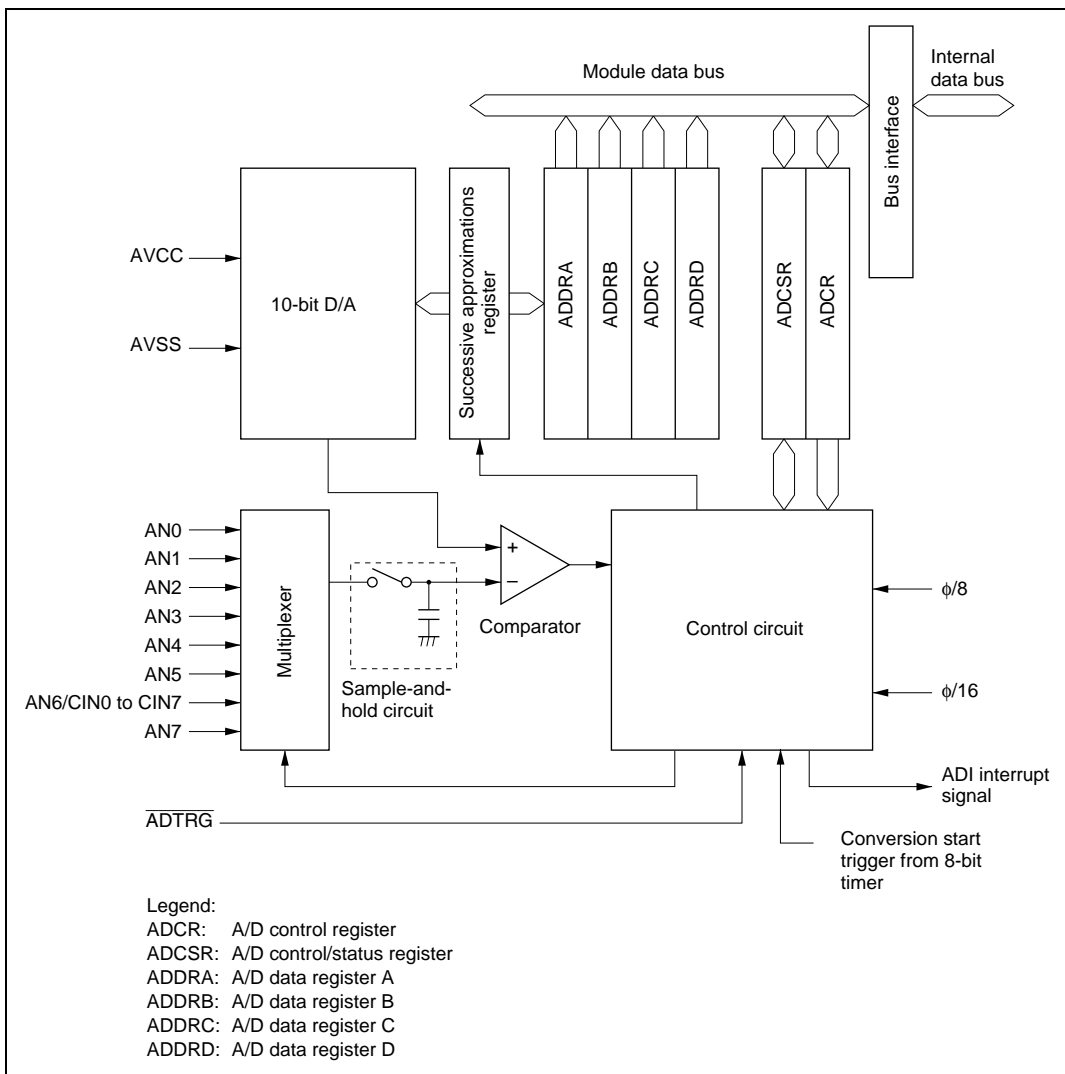


Figure 19.1 Block Diagram of A/D Converter

19.1.3 Pin Configuration

Table 19.1 summarizes the input pins used by the A/D converter.

The AVCC and AVSS pins are the power supply pins for the analog block in the A/D converter.

Table 19.1 A/D Converter Pins

| Pin Name | Symbol | I/O | Function |
|---------------------------------|---------------------------|-------|--|
| Analog power supply pin | AVCC | Input | Analog block power supply |
| Analog ground pin | AVSS | Input | Analog block ground and A/D conversion reference voltage |
| Analog input pin 0 | AN0 | Input | Analog input channel 0 |
| Analog input pin 1 | AN1 | Input | Analog input channel 1 |
| Analog input pin 2 | AN2 | Input | Analog input channel 2 |
| Analog input pin 3 | AN3 | Input | Analog input channel 3 |
| Analog input pin 4 | AN4 | Input | Analog input channel 4 |
| Analog input pin 5 | AN5 | Input | Analog input channel 5 |
| Analog input pin 6 | AN6 | Input | Analog input channel 6 |
| Analog input pin 7 | AN7 | Input | Analog input channel 7 |
| A/D external trigger input pin | $\overline{\text{ADTRG}}$ | Input | External trigger input for starting A/D conversion |
| Expansion A/D input pins 0 to 7 | CIN0 to CIN7 | Input | Expansion A/D conversion input (digital input pin) channels 0 to 7 |

19.1.4 Register Configuration

Table 19.2 summarizes the registers of the A/D converter.

Table 19.2 A/D Converter Registers

| Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|--------------------------------------|--------------|---------------------|---------------|-----------------------|
| A/D data register AH | ADDRAH | R | H'00 | H'FFE0 |
| A/D data register AL | ADDRAL | R | H'00 | H'FFE1 |
| A/D data register BH | ADDRBH | R | H'00 | H'FFE2 |
| A/D data register BL | ADDRBL | R | H'00 | H'FFE3 |
| A/D data register CH | ADDRCH | R | H'00 | H'FFE4 |
| A/D data register CL | ADDRCL | R | H'00 | H'FFE5 |
| A/D data register DH | ADDRDH | R | H'00 | H'FFE6 |
| A/D data register DL | ADDRDL | R | H'00 | H'FFE7 |
| A/D control/status register | ADCSR | R/(W) ^{*2} | H'00 | H'FFE8 |
| A/D control register | ADCR | R/W | H'3F | H'FFE9 |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 |
| | MSTPCRL | R/W | H'FF | H'FF87 |
| Keyboard comparator control register | KBCOMP | R/W | H'00 | H'FEE4 |

Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written in bit 7, to clear the flag.

19.2 Register Descriptions

19.2.1 A/D Data Registers A to D (ADDRA to ADDR D)

| | | | | | | | | | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|---|---|---|---|---|---|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | AD1 | AD0 | — | — | — | — | — | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R |

There are four 16-bit read-only ADDR registers, ADDRA to ADDR D, used to store the results of A/D conversion.

The 10-bit data resulting from A/D conversion is transferred to the ADDR register for the selected channel and stored there. The upper 8 bits of the converted data are transferred to the upper byte (bits 15 to 8) of ADDR, and the lower 2 bits are transferred to the lower byte (bits 7 and 6) and stored. Bits 5 to 0 are always read as 0.

The correspondence between the analog input channels and ADDR registers is shown in table 19.3.

The ADDR registers can always be read by the CPU. The upper byte can be read directly, but for the lower byte, data transfer is performed via a temporary register (TEMP). For details, see section 19.3, Interface to Bus Master.

The ADDR registers are initialized to H'0000 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Table 19.3 Analog Input Channels and Corresponding ADDR Registers

| Analog Input Channel | | A/D Data Register |
|----------------------|---------------------|-------------------|
| Group 0 | Group 1 | |
| AN0 | AN4 | ADDRA |
| AN1 | AN5 | ADDRB |
| AN2 | AN6 or CIN0 to CIN7 | ADDRC |
| AN3 | AN7 | ADDRD |

19.2.2 A/D Control/Status Register (ADCSR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|------|------|------|-----|-----|-----|-----|
| | ADF | ADIE | ADST | SCAN | CKS | CH2 | CH1 | CH0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Only 0 can be written in bit 7, to clear the flag.

ADCSR is an 8-bit readable/writable register that controls A/D conversion operations.

ADCSR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—A/D End Flag (ADF): Status flag that indicates the end of A/D conversion.

Bit 7

| ADF | Description |
|-----|---|
| 0 | [Clearing conditions] (Initial value) <ul style="list-style-type: none"> When 0 is written in the ADF flag after reading ADF = 1 When the DTC is activated by an ADI interrupt and ADDR is read |
| 1 | [Setting conditions] <ul style="list-style-type: none"> Single mode: When A/D conversion ends Scan mode: When A/D conversion ends on all specified channels |

Bit 6—A/D Interrupt Enable (ADIE): Selects enabling or disabling of interrupt (ADI) requests at the end of A/D conversion.

Bit 6

| ADIE | Description |
|------|--|
| 0 | A/D conversion end interrupt (ADI) request is disabled (Initial value) |
| 1 | A/D conversion end interrupt (ADI) request is enabled |

Bit 5—A/D Start (ADST): Selects starting or stopping of A/D conversion. Holds a value of 1 during A/D conversion.

The ADST bit can be set to 1 by software, a timer conversion start trigger, or the A/D external trigger input pin (ADTRG).

Bit 5

| ADST | Description |
|------|---|
| 0 | A/D conversion stopped (Initial value) |
| 1 | Single mode: A/D conversion is started. Cleared to 0 automatically when conversion on the specified channel ends Scan mode: A/D conversion is started. Conversion continues sequentially on the selected channels until ADST is cleared to 0 by software, a reset, or a transition to standby mode or module stop mode |

Bit 4—Scan Mode (SCAN): Selects single mode or scan mode as the A/D conversion operating mode. See section 19.4, Operation, for single mode and scan mode operation. Only set the SCAN bit while conversion is stopped.

Bit 4

| SCAN | Description |
|------|-----------------------------|
| 0 | Single mode (Initial value) |
| 1 | Scan mode |

Bit 3—Clock Select (CKS): Sets the A/D conversion time. Only change the conversion time while ADST = 0.

Bit 3

| CKS | Description |
|-----|---|
| 0 | Conversion time = 266 states (max.) (Initial value) |
| 1 | Conversion time = 134 states (max.) |

Bits 2 to 0—Channel Select 2 to 0 (CH2 to CH0): Together with the SCAN bit, these bits select the analog input channel(s).

One analog input channel can be switched to digital input.

Only set the input channel while conversion is stopped.

| Group Selection | Channel Selection | | Description | |
|-----------------|-------------------|-----|---------------------|-------------------------------|
| | CH1 | CH0 | Single Mode | Scan Mode |
| 0 | 0 | 0 | AN0 (Initial value) | AN0 |
| | | 1 | AN1 | AN0, AN1 |
| | 1 | 0 | AN2 | AN0 to AN2 |
| | | 1 | AN3 | AN0 to AN3 |
| 1 | 0 | 0 | AN4 | AN4 |
| | | 1 | AN5 | AN4, AN5 |
| | 1 | 0 | AN6 or CIN0 to CIN7 | AN4, AN5, AN6 or CIN0 to CIN7 |
| | | 1 | AN7 | AN4, AN5, AN6 or CIN0 to CIN7 |
| | | | AN7 | AN7 |

19.2.3 A/D Control Register (ADCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|---|---|---|---|---|---|
| | TRGS1 | TRGS0 | — | — | — | — | — | — |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | — | — | — | — | — | — |

ADCR is an 8-bit readable/writable register that enables or disables external triggering of A/D conversion operations.

ADCR is initialized to H'3F by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 7 and 6—Timer Trigger Select 1 and 0 (TRGS1, TRGS0): These bits select enabling or disabling of the start of A/D conversion by a trigger signal. Only set bits TRGS1 and TRGS0 while conversion is stopped.

| Bit 7 | Bit 6 | Description |
|-------|-------|---|
| TRGS1 | TRGS0 | |
| 0 | 0 | Start of A/D conversion by external trigger is disabled (Initial value) |
| | 1 | Start of A/D conversion by external trigger is disabled |
| 1 | 0 | Start of A/D conversion by external trigger (8-bit timer) is enabled |
| | 1 | Start of A/D conversion by external trigger pin is enabled |

Bits 5 to 0—Reserved: Should always be written 1.

Note: Some of these bits are readable/writable in products other than the HD64F2138, HD64F2134, HD64F2132R, HD6432132, and HD6432130, however, when writing, be sure to write 1 here for software compatibility.

19.2.4 Keyboard Comparator Control Register (KBCOMP)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|--------|--------|--------|-------|-------|-------|-------|
| | IrE | IrCKS2 | IrCKS1 | IrCKS0 | KBADE | KBCH2 | KBCH1 | KBCH0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

KBCOMP is an 8-bit readable/writable register that controls the SCI2 IrDA function and selects the CIN input channels for A/D conversion.

KBCOMP is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4—IrDA Control: See the description in section 15.2.11, Keyboard Comparator Control Register (KBCOMP).

Bit 3—Keyboard A/D Enable: Selects either analog input pin (AN6) or digital input pin (CIN0 to CIN7) for A/D converter channel 6 input. If digital input pins are selected, input on A/D converter channel 7 will not be converted correctly.

Bits 2 to 0—Keyboard A/D Channel Select 2 to 0 (KBCH2 to KBCH0): These bits select the channels for A/D conversion from among the digital input pins. Only set the input channel while A/D conversion is stopped.

| Bit 3 | Bit 2 | Bit 1 | Bit 0 | A/D Converter Channel 6 Input | A/D Converter Channel 7 Input | | |
|-------|-------|-------|-------|-------------------------------|-------------------------------|-----------|-----------|
| KBADE | KBCH2 | KBCH1 | KBCH0 | | | | |
| 0 | — | — | — | AN6 | AN7 | | |
| 1 | 0 | 0 | 0 | CIN0 | Undefined | | |
| | | | 1 | CIN1 | Undefined | | |
| | | | 1 | 0 | CIN2 | Undefined | |
| | | | | 1 | CIN3 | Undefined | |
| | | | 1 | 0 | 0 | CIN4 | Undefined |
| | | | | | 1 | CIN5 | Undefined |
| | | | 1 | 0 | CIN6 | Undefined | |
| | | 1 | CIN7 | Undefined | | | |

19.2.5 Module Stop Control Register (MSTPCR)

| Bit | MSTPCRH | | | | | | | | MSTPCRL | | | | | | | |
|---------------|---------|--------|--------|--------|--------|--------|-------|-------|---------|-------|-------|-------|-------|-------|-------|-------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | MSTP15 | MSTP14 | MSTP13 | MSTP12 | MSTP11 | MSTP10 | MSTP9 | MSTP8 | MSTP7 | MSTP6 | MSTP5 | MSTP4 | MSTP3 | MSTP2 | MSTP1 | MSTP0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control.

When the MSTP9 bit in MSTPCR is set to 1, A/D converter operation stops at the end of the bus cycle and a transition is made to module stop mode. Registers cannot be read or written to in module stop mode. For details, see section 24.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 1—Module Stop (MSTP9): Specifies the A/D converter module stop mode.

MSTPCRH

Bit 1

| MSTP9 | Description |
|-------|---|
| 0 | A/D converter module stop mode is cleared |
| 1 | A/D converter module stop mode is set (Initial value) |

19.3 Interface to Bus Master

ADDRA to ADDR_D are 16-bit registers, but the data bus to the bus master is only 8 bits wide. Therefore, in accesses by the bus master, the upper byte is accessed directly, but the lower byte is accessed via a temporary register (TEMP).

A data read from ADDR is performed as follows. When the upper byte is read, the upper byte value is transferred to the CPU and the lower byte value is transferred to TEMP. Next, when the lower byte is read, the TEMP contents are transferred to the CPU.

When reading ADDR, always read the upper byte before the lower byte. It is possible to read only the upper byte, but if only the lower byte is read, incorrect data may be obtained.

Figure 19.2 shows the data flow for ADDR access.

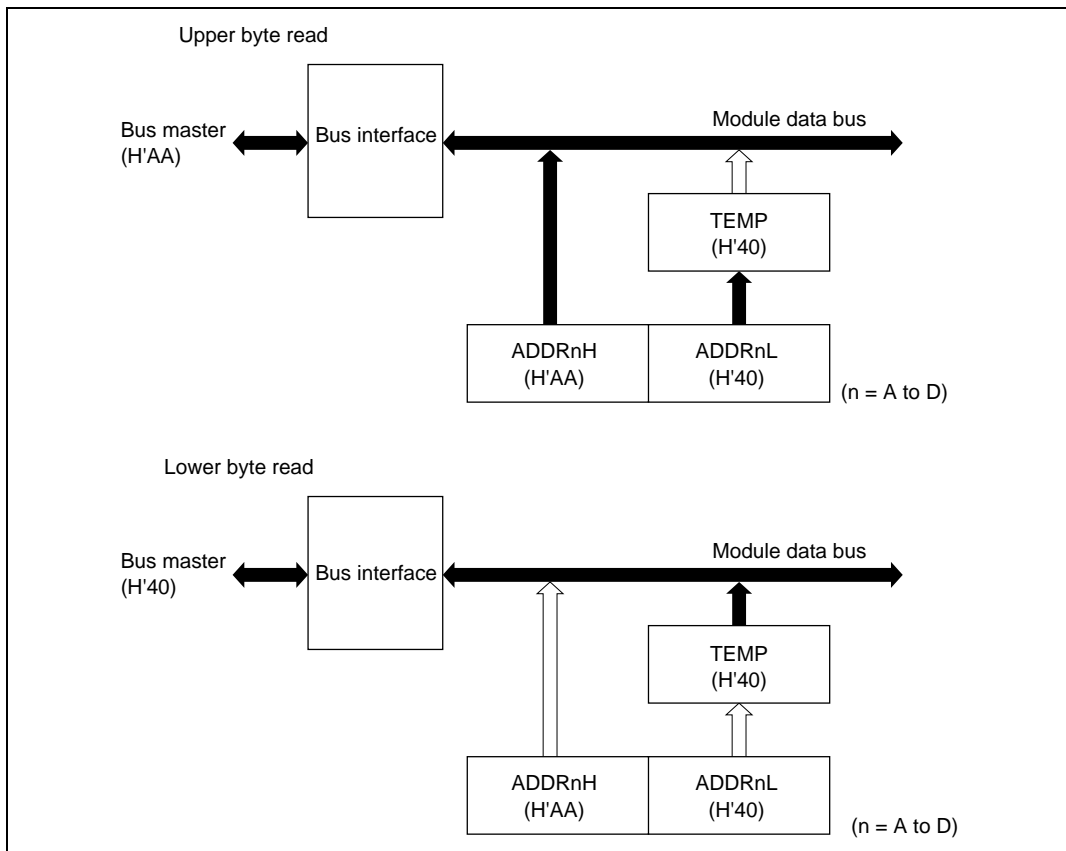


Figure 19.2 ADDR Access Operation (Reading H'AA40)

19.4 Operation

The A/D converter operates by successive approximations with 10-bit resolution. It has two operating modes: single mode and scan mode.

19.4.1 Single Mode (SCAN = 0)

Single mode is selected when A/D conversion is to be performed on a single channel only. A/D conversion is started when the ADST bit is set to 1 by software, or by external trigger input. The ADST bit remains set to 1 during A/D conversion, and is automatically cleared to 0 when conversion ends.

On completion of conversion, the ADF flag is set to 1. If the ADIE bit is set to 1 at this time, an ADI interrupt request is generated. The ADF flag is cleared by writing 0 after reading ADCSR.

When the operating mode or analog input channel must be changed during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1 to start A/D conversion again. The ADST bit can be set at the same time as the operating mode or input channel is changed.

Typical operations when channel 1 (AN1) is selected in single mode are described next. Figure 19.3 shows a timing diagram for this example.

1. Single mode is selected (SCAN = 0), input channel AN1 is selected (CH1 = 0, CH0 = 1), the A/D interrupt is enabled (ADIE = 1), and A/D conversion is started (ADST = 1).
2. When A/D conversion is completed, the result is transferred to ADDR0. At the same time the ADF flag is set to 1, the ADST bit is cleared to 0, and the A/D converter becomes idle.
3. Since ADF = 1 and ADIE = 1, an ADI interrupt is requested.
4. The A/D interrupt handling routine starts.
5. The routine reads ADCSR, then writes 0 to the ADF flag.
6. The routine reads and processes the conversion result (ADDR0).
7. Execution of the A/D interrupt handling routine ends. After that, if the ADST bit is set to 1, A/D conversion starts again and steps 2 to 7 are repeated.

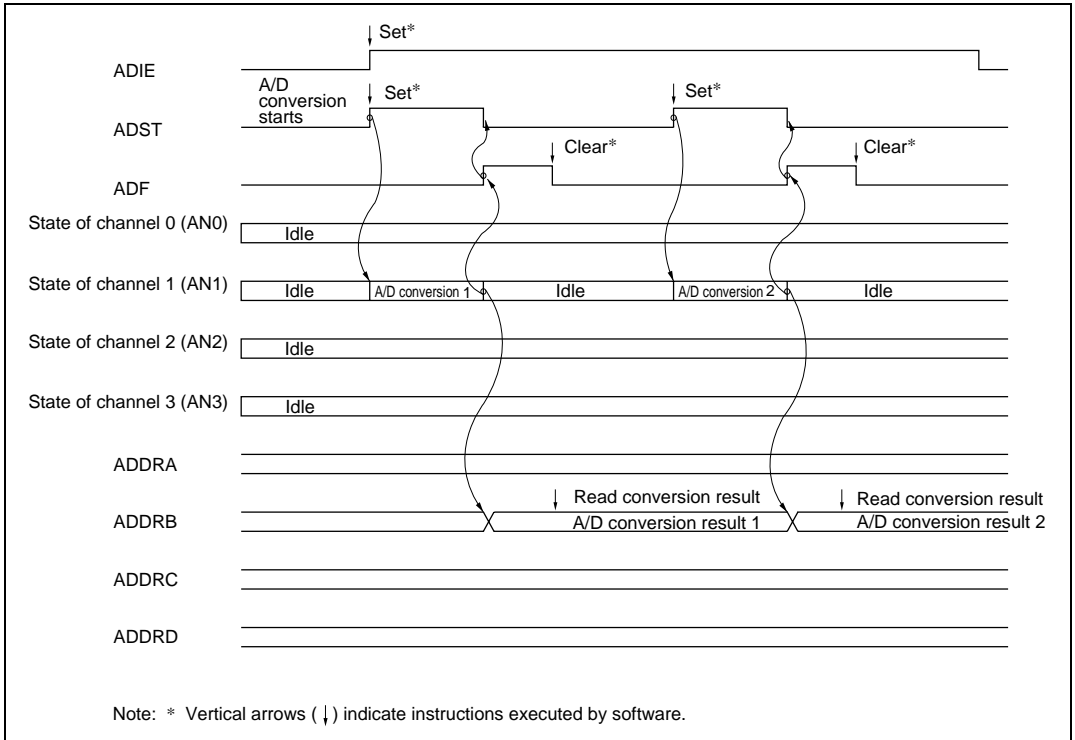


Figure 19.3 Example of A/D Converter Operation (Single Mode, Channel 1 Selected)

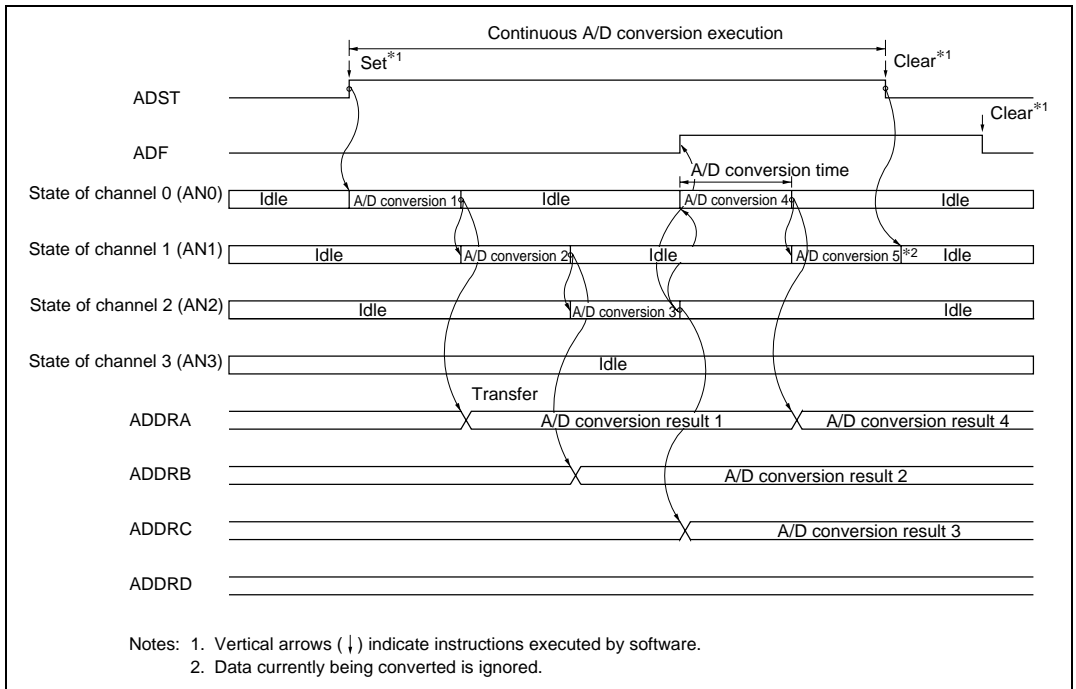
19.4.2 Scan Mode (SCAN = 1)

Scan mode is useful for monitoring analog inputs in a group of one or more channels. When the ADST bit is set to 1 by software, or by timer or external trigger input, A/D conversion starts on the first channel in the group (AN0 when CH2 = 0; AN4 when CH2 = 1). When two or more channels are selected, after conversion of the first channel ends, conversion of the second channel (AN1 or AN5) starts immediately. A/D conversion continues cyclically on the selected channels until the ADST bit is cleared to 0. The conversion results are transferred for storage into the ADDR registers corresponding to the channels.

When the operating mode or analog input channel must be changed during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1 to start A/D conversion again. The ADST bit can be set at the same time as the operating mode or input channel is changed.

Typical operations when three channels (AN0 to AN2) are selected in scan mode are described next. Figure 19.4 shows a timing diagram for this example.

1. Scan mode is selected (SCAN = 1), scan group 0 is selected (CH2 = 0), analog input channels AN0 to AN2 are selected (CH1 = 1, CH0 = 0), and A/D conversion is started (ADST = 1)
2. When A/D conversion of the first channel (AN0) is completed, the result is transferred to ADDRA. Next, conversion of the second channel (AN1) starts automatically.
3. Conversion proceeds in the same way through the third channel (AN2).
4. When conversion of all the selected channels (AN0 to AN2) is completed, the ADF flag is set to 1 and conversion of the first channel (AN0) starts again. If the ADIE bit is set to 1 at this time, an ADI interrupt is requested after A/D conversion ends.
5. Steps 2 to 4 are repeated as long as the ADST bit remains set to 1. When the ADST bit is cleared to 0, A/D conversion stops. After that, if the ADST bit is set to 1, A/D conversion starts again from the first channel (AN0).



**Figure 19.4 Example of A/D Converter Operation
(Scan Mode, Channels AN0 to AN2 Selected)**

19.4.3 Input Sampling and A/D Conversion Time

The A/D converter has an on-chip sample-and-hold circuit. The A/D converter samples the analog input at a time t_D after the ADST bit is set to 1, then starts conversion. Figure 19.5 shows the A/D conversion timing. Table 19.4 indicates the A/D conversion time.

As indicated in figure 19.5, the A/D conversion time includes t_D and the input sampling time. The length of t_D varies depending on the timing of the write access to ADCSR. The total conversion time therefore varies within the ranges indicated in table 19.4.

In scan mode, the values given in table 19.4 apply to the first conversion time. In the second and subsequent conversions the conversion time is fixed at 256 states when $CKS = 0$ or 128 states when $CKS = 1$.

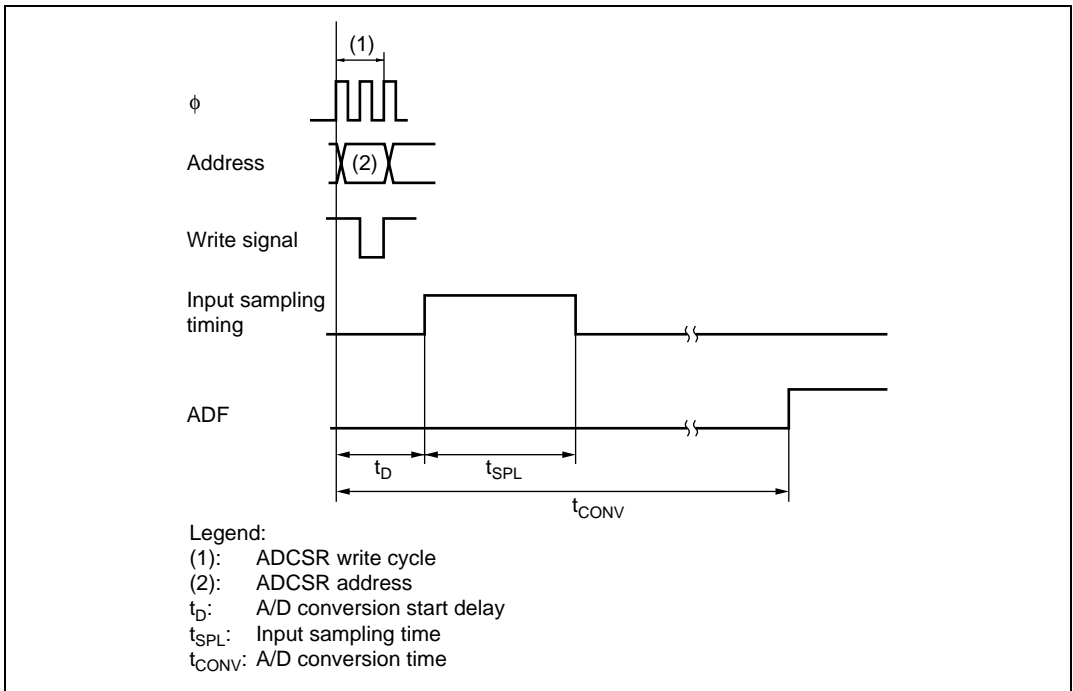


Figure 19.5 A/D Conversion Timing

Table 19.4 A/D Conversion Time (Single Mode)

| Item | Symbol | CKS = 0 | | | CKS = 1 | | |
|----------------------------|------------|---------|-----|-----|---------|-----|-----|
| | | Min | Typ | Max | Min | Typ | Max |
| A/D conversion start delay | t_D | 10 | — | 17 | 6 | — | 9 |
| Input sampling time | t_{SPL} | — | 63 | — | — | 31 | — |
| A/D conversion time | t_{CONV} | 259 | — | 266 | 131 | — | 134 |

Note: Values in the table are the number of states.

19.4.4 External Trigger Input Timing

A/D conversion can be externally triggered. When the TRGS1 and TRGS0 bits are set to 11 in ADCR, external trigger input is enabled at the $\overline{\text{ADTRG}}$ pin. A falling edge at the $\overline{\text{ADTRG}}$ pin sets the ADST bit to 1 in ADCSR, starting A/D conversion. Other operations, in both single and scan modes, are the same as when the ADST bit is set to 1 by software. Figure 19.6 shows the timing.

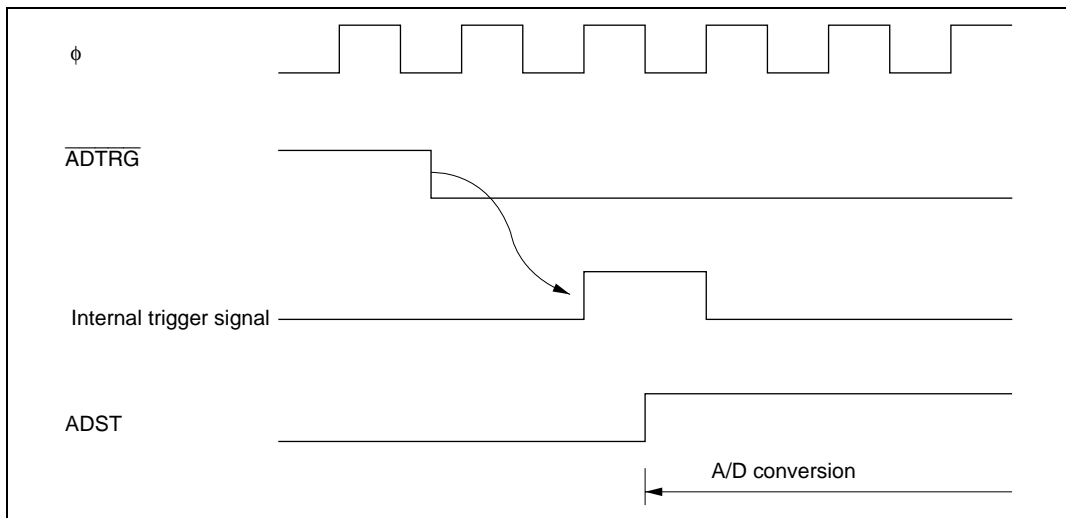


Figure 19.6 External Trigger Input Timing

19.5 Interrupts

The A/D converter generates an interrupt (ADI) at the end of A/D conversion. The ADI interrupt request can be enabled or disabled by the ADIE bit in ADCSR.

19.6 Usage Notes

The following points should be noted when using the A/D converter.

Setting Range of Analog Power Supply and Other Pins:

1. Analog input voltage range

The voltage applied to the ANn analog input pins during A/D conversion should be in the range $AV_{SS} \leq ANn \leq AV_{CC}$ ($n = 0$ to 7).

2. Digital input voltage range

The voltage applied to the CINn digital input pins should be in the range $AV_{SS} \leq CINn \leq AV_{CC}$ and $V_{SS} \leq CINn \leq V_{CC}$ ($n = 0$ to 7).

3. Relation between AV_{CC} , AV_{SS} and V_{CC} , V_{SS}

As the relationship between AV_{CC} , AV_{SS} and V_{CC} , V_{SS} , set $AV_{SS} = V_{SS}$. If the A/D converter is not used, the AVCC and AVSS pins must on no account be left open.

If conditions 1 to 3 above are not met, the reliability of the device may be adversely affected.

Notes on Board Design: In board design, digital circuitry and analog circuitry should be as mutually isolated as possible, and layout in which digital circuit signal lines and analog circuit signal lines cross or are in close proximity should be avoided as far as possible. Failure to do so may result in incorrect operation of the analog circuitry due to inductance, adversely affecting A/D conversion values.

Also, digital circuitry must be isolated from the analog input signals (AN0 to AN7), and analog power supply (AVCC) by the analog ground (AVSS). Also, the analog ground (AVSS) should be connected at one point to a stable digital ground (VSS) on the board.

Notes on Noise Countermeasures: A protection circuit connected to prevent damage due to an abnormal voltage such as an excessive surge at the analog input pins (AN0 to AN7) should be connected between AVCC and AVSS as shown in figure 19.7.

Also, the bypass capacitors connected to AVCC and the filter capacitor connected to AN0 to AN7 must be connected to AVSS.

If a filter capacitor is connected as shown in figure 19.7, the input currents at the analog input pins (AN0 to AN7) are averaged, and so an error may arise. Also, when A/D conversion is performed frequently, as in scan mode, if the current charged and discharged by the capacitance of the sample-and-hold circuit in the A/D converter exceeds the current input via the input impedance

(R_{in}), an error will arise in the analog input pin voltage. Careful consideration is therefore required when deciding the circuit constants.

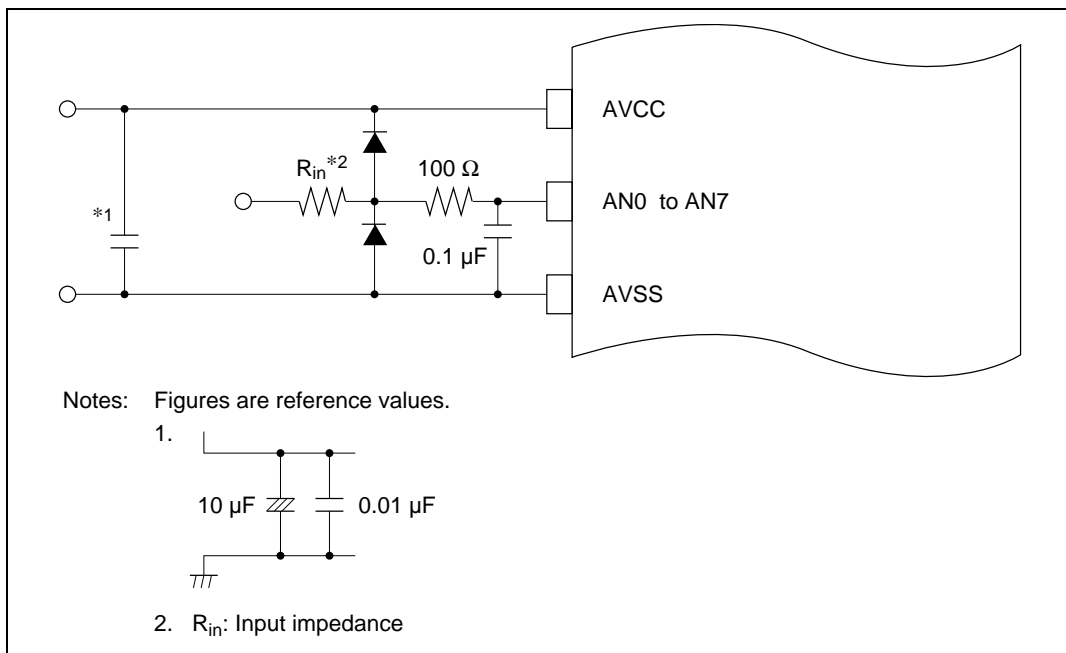


Figure 19.7 Example of Analog Input Protection Circuit

Table 19.5 Analog Pin Specifications

| Item | Min | Max | Unit |
|-------------------------------------|-----|-----|------------|
| Analog input capacitance | — | 20 | pF |
| Permissible signal source impedance | — | 10* | k Ω |

Note: * When $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}$ and $\phi \leq 12 \text{ MHz}$

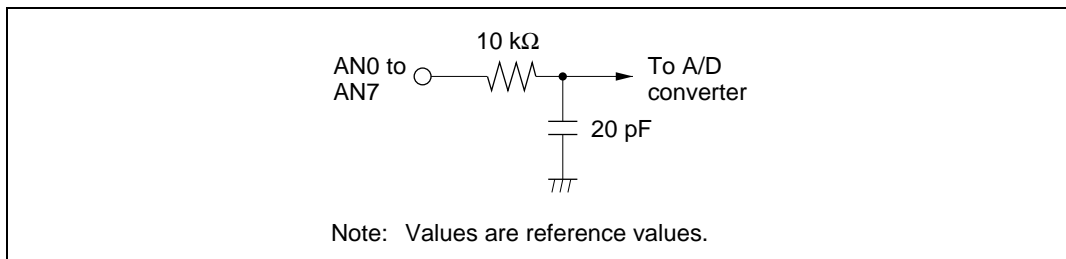


Figure 19.8 Analog Input Pin Equivalent Circuit

A/D Conversion Precision Definitions: H8S/2138 Group and H8S/2134 Group A/D conversion precision definitions are given below.

- **Resolution**
The number of A/D converter digital output codes
- **Offset error**
The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from the minimum voltage value B'0000000000 (H'000) to B'0000000001 (H'001) (see figure 19.10).
- **Full-scale error**
The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from B'1111111110 (H'3FE) to B'1111111111 (H'3FF) (see figure 19.10).
- **Quantization error**
The deviation inherent in the A/D converter, given by 1/2 LSB (see figure 19.9).
- **Nonlinearity error**
The error with respect to the ideal A/D conversion characteristic between the zero voltage and the full-scale voltage. Does not include the offset error, full-scale error, or quantization error.
- **Absolute precision**
The deviation between the digital value and the analog input value. Includes the offset error, full-scale error, quantization error, and nonlinearity error.

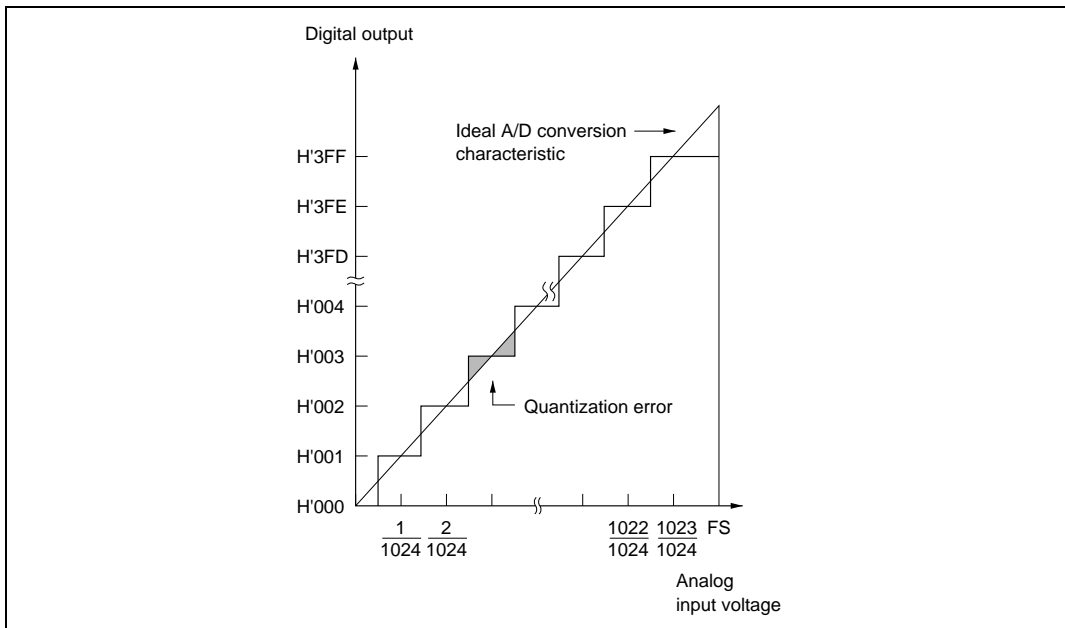


Figure 19.9 A/D Conversion Precision Definitions (1)

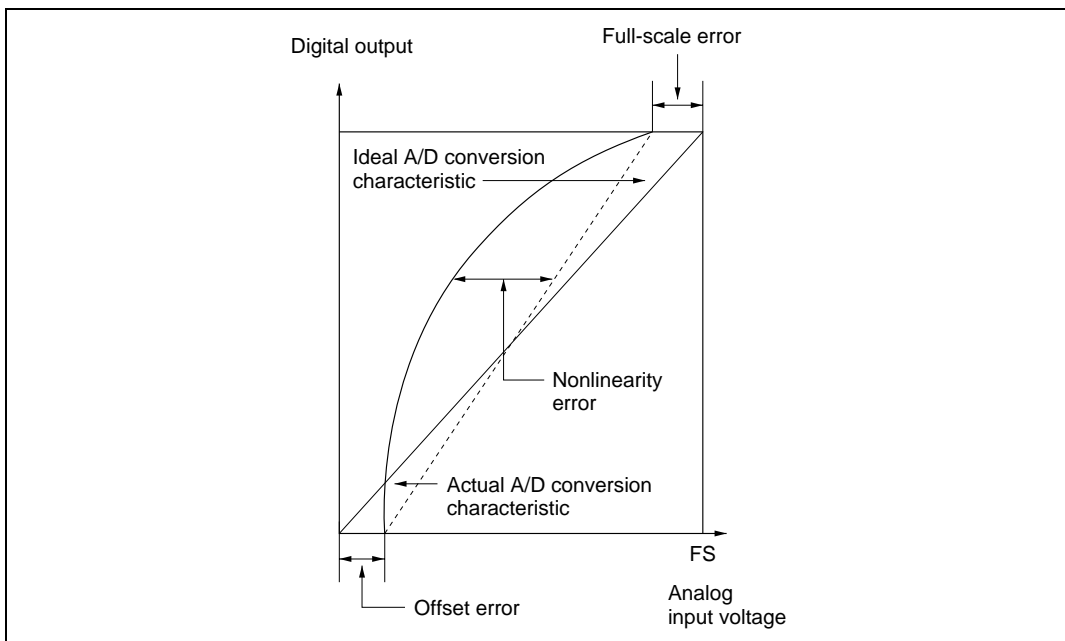


Figure 19.10 A/D Conversion Precision Definitions (2)

Permissible Signal Source Impedance: H8S/2138 Group and H8S/2134 Group analog input is designed so that conversion precision is guaranteed for an input signal for which the signal source impedance is $10\text{ k}\Omega$ ($V_{cc} = 4.0$ to 5.5 V , when $\phi \leq 12\text{ MHz}$ or $CKS = 0$) or less. This specification is provided to enable the A/D converter's sample-and-hold circuit input capacitance to be charged within the sampling time; if the sensor output impedance exceeds $10\text{ k}\Omega$ ($V_{cc} = 4.0$ to 5.5 V , when $\phi \leq 12\text{ MHz}$ or $CKS = 0$), charging may be insufficient and it may not be possible to guarantee the A/D conversion precision.

However, if a large capacitance is provided externally, the input load will essentially comprise only the internal input resistance of $10\text{ k}\Omega$, and the signal source impedance is ignored.

But since a low-pass filter effect is obtained in this case, it may not be possible to follow an analog signal with a large differential coefficient (e.g., $5\text{ mV}/\mu\text{sec}$ or greater).

When converting a high-speed analog signal, a low-impedance buffer should be inserted.

Influences on Absolute Precision: Adding capacitance results in coupling with GND, and therefore noise in GND may adversely affect absolute precision. Be sure to make the connection to an electrically stable GND such as AV_{SS} .

Care is also required to insure that filter circuits do not communicate with digital signals on the mounting board, so acting as antennas.

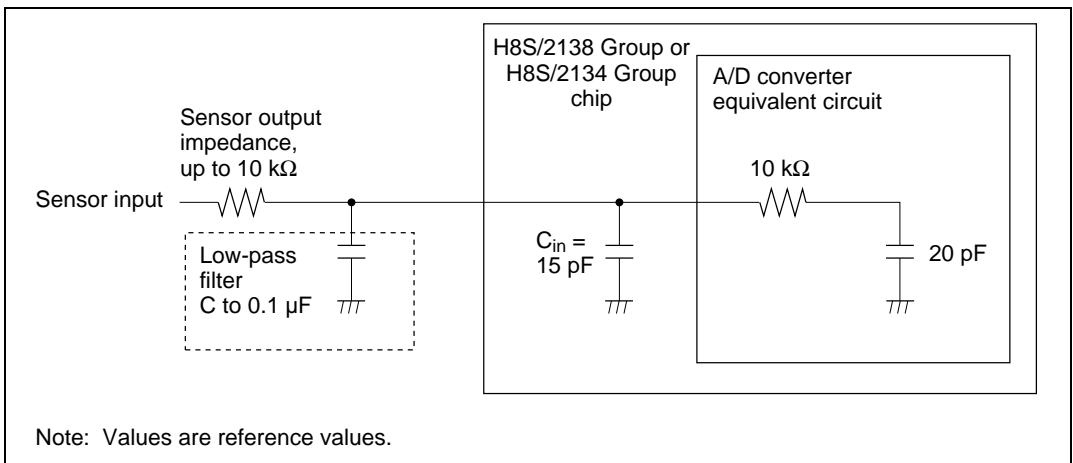


Figure 19.11 Example of Analog Input Circuit

Section 20 RAM

20.1 Overview

The H8S/2138, H8S/2134, and H8S/2133 have 4 kbytes of on-chip high-speed static RAM, and the H8S/2137, H8S/2132, and H8S/2130 have 2 kbytes. The on-chip RAM is connected to the CPU by a 16-bit data bus, enabling both byte data and word data to be accessed in one state. This makes it possible to perform fast word data transfer.

The on-chip RAM can be enabled or disabled by means of the RAM enable bit (RAME) in the system control register (SYSCR).

20.1.1 Block Diagram

Figure 20.1 shows a block diagram of the on-chip RAM.

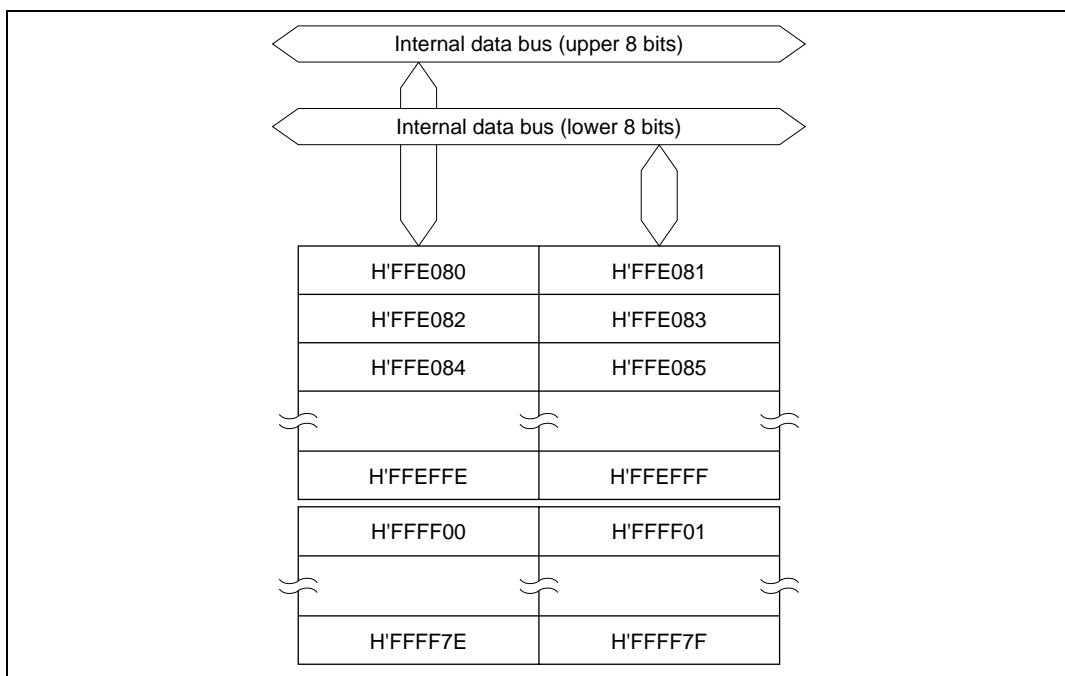


Figure 20.1 Block Diagram of RAM (H8S/2138, H8S/2134, H8S/2133)

20.1.2 Register Configuration

The on-chip RAM is controlled by SYSCR. Table 20.1 shows the register configuration.

Table 20.1 Register Configuration

| Name | Abbreviation | R/W | Initial Value | Address* |
|-------------------------|--------------|-----|---------------|----------|
| System control register | SYSCR | R/W | H'09 | H'FFC4 |

Note: * Lower 16 bits of the address.

20.2 System Control Register (SYSCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|------|-------|-----|------|
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

The on-chip RAM is enabled or disabled by the RAME bit in SYSCR. For details of other bits in SYSCR, see section 3.2.2, System Control Register (SYSCR).

Bit 0—RAM Enable (RAME): Enables or disables the on-chip RAM. The RAME bit is initialized when the reset state is released. It is not initialized in software standby mode.

Bit 0

| RAME | Description |
|------|--|
| 0 | On-chip RAM is disabled |
| 1 | On-chip RAM is enabled (Initial value) |

20.3 Operation

20.3.1 Expanded Mode (Modes 1, 2, and 3 (EXPE = 1))

When the RAME bit is set to 1, accesses to H8S/2138, H8S/2134, and H8S/2133 addresses H'(FF)E080 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, and H8S/2137, H8S/2132, and H8S/2130 addresses H'(FF)E880 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, are directed to the on-chip RAM. When the RAME bit is cleared to 0, accesses to addresses H'(FF)E080 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, are directed to the off-chip address space.

Since the on-chip RAM is connected to the bus master by a 16-bit data bus, it can be written to and read in byte or word units. Each type of access is performed in one state.

Even addresses use the upper 8 bits, and odd addresses use the lower 8 bits. Word data must start at an even address.

20.3.2 Single-Chip Mode (Modes 2 and 3 (EXPE = 0))

When the RAME bit is set to 1, accesses to H8S/2138, H8S/2134, and H8S/2133 addresses H'(FF)E080 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, and H8S/2137, H8S/2132, and H8S/2130 addresses H'(FF)E880 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, are directed to the on-chip RAM. When the RAME bit is cleared to 0, the on-chip RAM is not accessed. Undefined values are read from these bits, and writing is invalid.

Since the on-chip RAM is connected to the bus master by a 16-bit data bus, it can be written to and read in byte or word units. Each type of access is performed in one state.

Even addresses use the upper 8 bits, and odd addresses use the lower 8 bits. Word data must start at an even address.

Section 21 ROM

(Mask ROM Version, H8S/2138 F-ZTAT, H8S/2134 F-ZTAT, and H8S/2132 F-ZTAT)

21.1 Overview

The H8S/2138 and H8S/2134 have 128 kbytes of on-chip ROM, the H8S/2133 has 96 kbytes, the H8S/2137 and H8S/2132 have 64 kbytes, and the H8S/2130 has 32 kbytes. The ROM is connected to the CPU by a 16-bit data bus. The CPU accesses both byte and word data in one state, enabling faster instruction fetches and higher processing speed.

The mode pins (MD1 and MD0) and the EXPE bit in MDCR can be set to enable or disable the on-chip ROM.

The lineups for the H8S/2138, H8S/2134, and H8S/2132 include flash memory versions which can be erased and programmed on-board as well as by a general-purpose PROM programmer.

21.1.1 Block Diagram

Figure 21.1 shows a block diagram of the ROM.

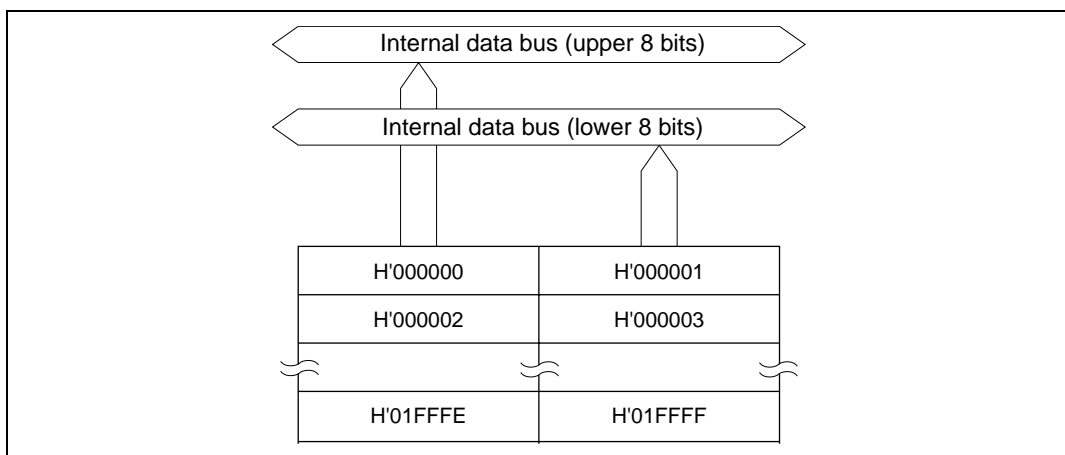


Figure 21.1 ROM Block Diagram (H8S/2138, H8S/2134)

21.1.2 Register Configuration

The H8S/2138 Group and H8S/2134 Group on-chip ROM is controlled by the operating mode and register MDCR. The register configuration is shown in table 21.1.

Table 21.1 ROM Register

| Register Name | Abbreviation | R/W | Initial Value | Address* |
|-----------------------|--------------|-----|--|----------|
| Mode control register | MDCR | R/W | Undefined Depends on the operating mode | H'FFC5 |

Note: * Lower 16 bits of the address.

21.2 Register Descriptions

21.2.1 Mode Control Register (MDCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|------|------|
| | EXPE | — | — | — | — | — | MDS1 | MDS0 |
| Initial value | —* | 0 | 0 | 0 | 0 | 0 | —* | —* |
| Read/Write | R/W* | — | — | — | — | — | R | R |

Note: * Determined by the MD1 and MD0 pins.

MDCR is an 8-bit register used to set the H8S/2138 Group or H8S/2134 Group operating mode and monitor the current operating mode.

The EXPE bit is initialized in accordance with the mode pin states by a reset and in hardware standby mode.

Bit 7—Expanded Mode Enable (EXPE): Sets expanded mode. In mode 1, EXPE is fixed at 1 and cannot be modified. In modes 2 and 3, EXPE has an initial value of 0 and can be read or written.

Bit 7

| EXPE | Description |
|------|---------------------------|
| 0 | Single-chip mode selected |
| 1 | Expanded mode selected |

Bits 6 to 2—Reserved: These bits cannot be modified and are always read as 0.

Bits 1 and 0—Mode Select 1 and 0 (MDS1, MDS0): These bits indicate values that reflects the input levels of mode pins MD1 and MD0 (the current operating mode). Bits MDS1 and MDS0 correspond to pins MD1 and MD0, respectively. These are read-only bits, and cannot be modified. When MDCR is read, the input levels of mode pins MD1 and MD0 are latched in these bits.

21.3 Operation

The on-chip ROM is connected to the CPU by a 16-bit data bus, and both byte and word data is accessed in one state. Even addresses are connected to the upper 8 bits, and odd addresses to the lower 8 bits. Word data must start at an even address.

The mode pins (MD1 and MD0) and the EXPE bit in MDCR can be set to enable or disable the on-chip ROM, as shown in table 21.2.

In normal mode, the maximum amount of ROM that can be used is 56 kbytes.

Table 21.2 Operating Modes and ROM

| Operating Mode | | | | | | |
|--------------------------|--------------------------|---|-----------|-----|------|-----------------------------|
| MCU Operating Mode | CPU Operating Mode | Description | Mode Pins | | MDCR | On-Chip ROM |
| | | | MD1 | MD0 | EXPE | |
| Mode 1 | Normal | Expanded mode with on-chip ROM disabled | 0 | 1 | 1 | Disabled |
| Mode 2 | Advanced | Single-chip mode | 1 | 0 | 0 | Enabled* |
| | Advanced | Expanded mode with on-chip ROM enabled | | | 1 | |
| Mode 3 | Normal | Single-chip mode | | 1 | 0 | Enabled (max. 56 kbytes) |
| | Normal | Expanded mode with on-chip ROM enabled | | | 1 | |

Note: * 128 kbytes in the H8S/2138 and H8S/2134, 96 kbytes in the H8S/2133, 64 kbytes in the H8S/2137 and H8S/2132, and 32 kbytes in the H8S/2130.

21.4 Overview of Flash Memory

21.4.1 Features

The features of the flash memory are summarized below.

- Four flash memory operating modes

- Program mode
- Erase mode
- Program-verify mode
- Erase-verify mode

- Programming/erase methods

The flash memory is programmed 32 bytes at a time. Erasing is performed by block erase (in single-block units). When erasing multiple blocks, the individual blocks must be erased sequentially. Block erasing can be performed as required on 1-kbyte, 8-kbyte, 16-kbyte, 28-kbyte, and 32-kbyte blocks.

- Programming/erase times

The flash memory programming time is 10 ms (typ.) for simultaneous 32-byte programming, equivalent to 300 μ s (typ.) per byte, and the erase time is 100 ms (typ.) per block.

- Reprogramming capability

The flash memory can be reprogrammed up to 100 times.

- On-board programming modes

There are two modes in which flash memory can be programmed/erased/verified on-board:

- Boot mode
- User program mode

- Automatic bit rate adjustment

With data transfer in boot mode, the bit rate of the H8S/2138 Group or H8S/2134 Group chip can be automatically adjusted to match the transfer bit rate of the host.

- Protect modes

There are three protect modes, hardware, software, and error protect, which allow protected status to be designated for flash memory program/erase/verify operations.

- Programmer mode

Flash memory can be programmed/erased in programmer mode, using a PROM programmer, as well as in on-board programming mode.

21.4.2 Block Diagram

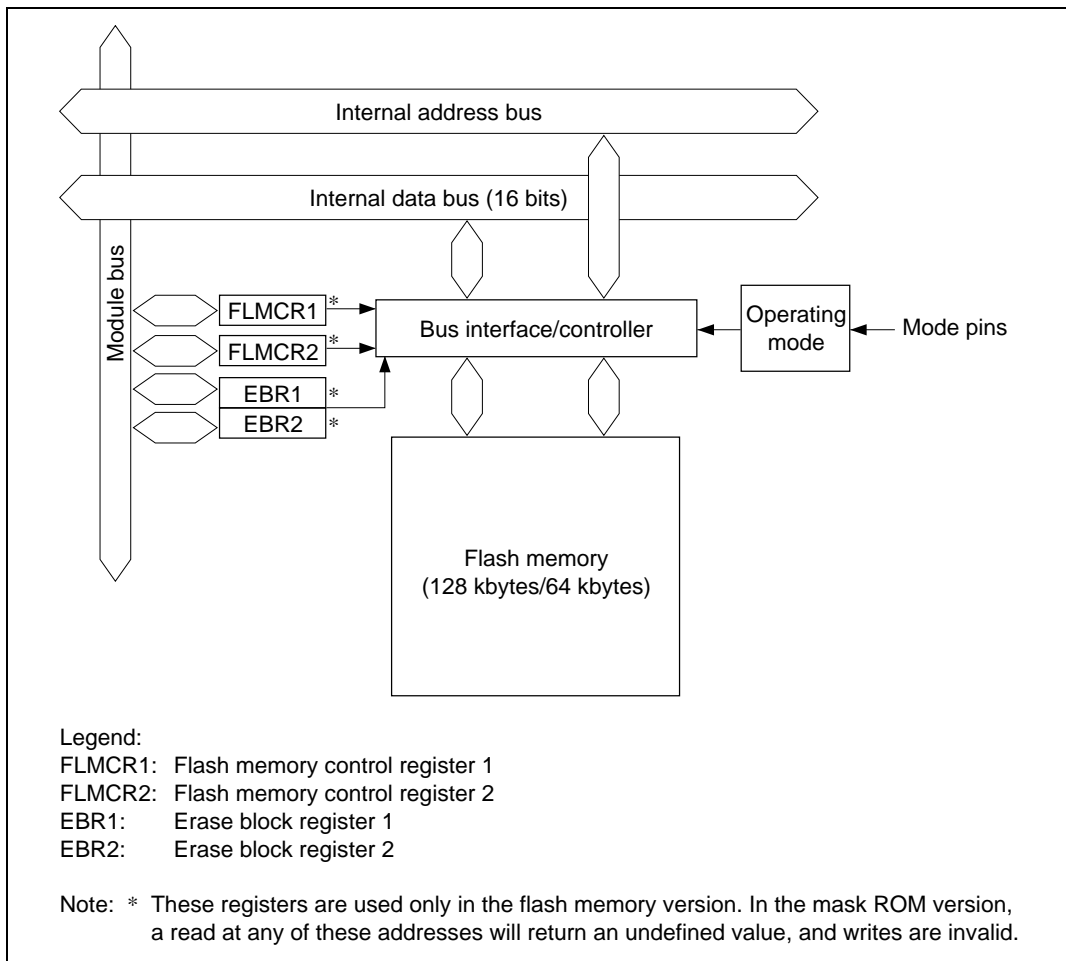


Figure 21.2 Block Diagram of Flash Memory

21.4.3 Flash Memory Operating Modes

Mode Transitions: When the mode pins are set in the reset state and a reset-start is executed, the MCU enters one of the operating modes shown in figure 21.3. In user mode, flash memory can be read but not programmed or erased.

Flash memory can be programmed and erased in boot mode, user program mode, and programmer mode.

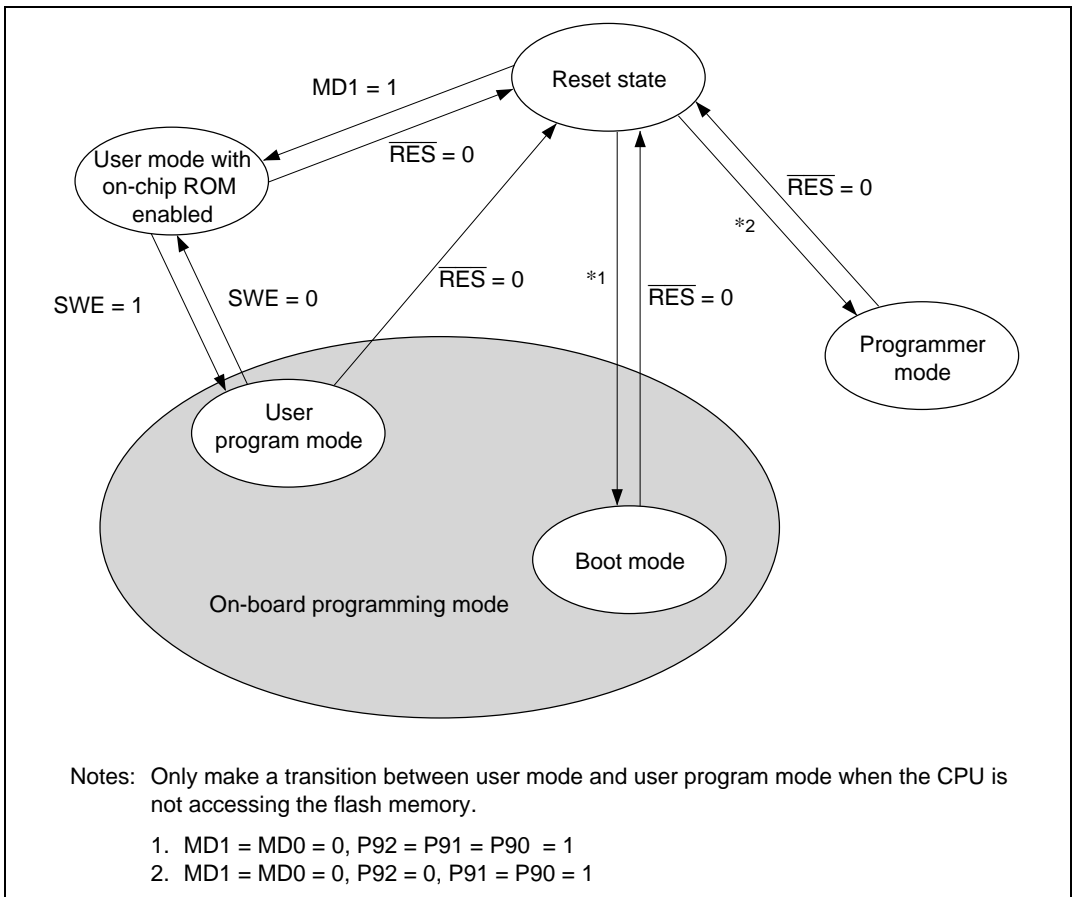


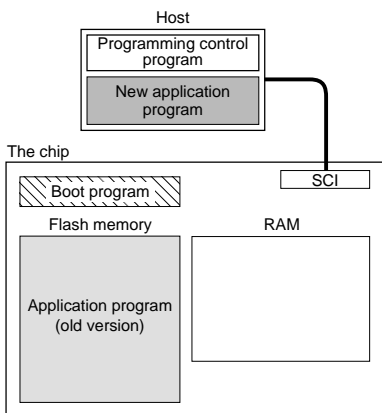
Figure 21.3 Flash Memory Mode Transitions

On-Board Programming Modes

• Boot mode

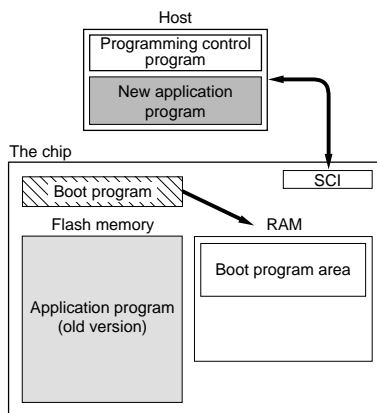
1. Initial state

The flash memory is in the erased state when the device is shipped. The description here applies to the case where the old program version or data is being rewritten. The user should prepare the programming control program and new application program beforehand in the host.



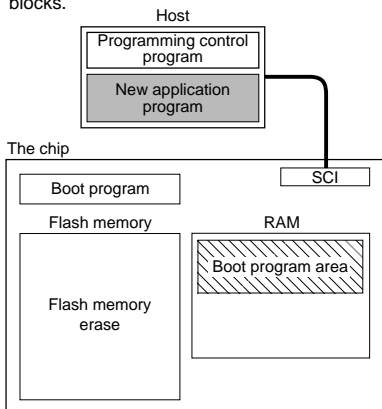
2. SCI communication check

When boot mode is entered, the boot program in the chip (originally incorporated in the chip) is started, an SCI communication check is carried out, and the boot program required for flash memory erasing is automatically transferred to the RAM boot program area.



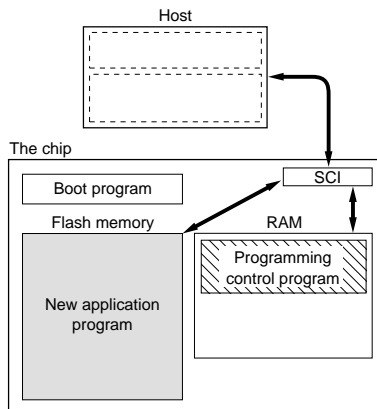
3. Flash memory initialization

The erase program in the boot program area (in RAM) is executed, and the flash memory is initialized (to H'FF). In boot mode, entire flash memory erasure is performed, without regard to blocks.



4. Writing new application program

The programming control program transferred from the host to RAM by SCI communication is executed, and the new application program in the host is written into the flash memory.




 Program execution state

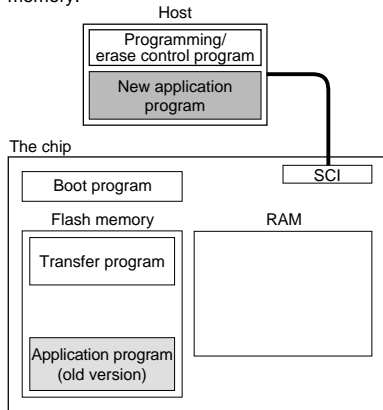
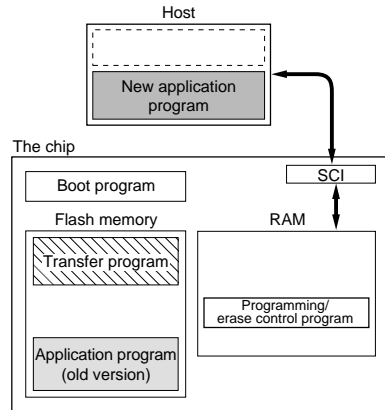
Figure 21.4 Boot Mode

- User program mode

1. Initial state

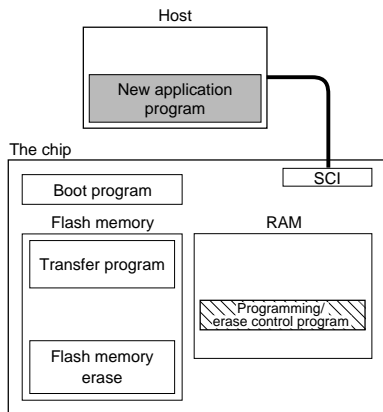
(1) The program that will transfer the programming/ erase control program to on-chip RAM should be written into the flash memory by the user beforehand.

(2) The programming/erase control program should be prepared in the host or in the flash memory.

2. Programming/erase control program transfer
Executes the transfer program in the flash memory, and transfers the programming/erase control program to RAM.

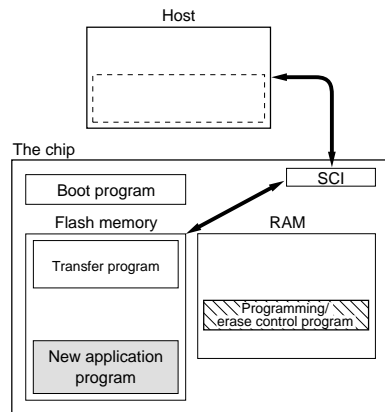
3. Flash memory initialization

The programming/erase program in RAM is executed, and the flash memory is initialized (to H'FF). Erasing can be performed in block units, but not in byte units.



4. Writing new application program

Next, the new application program in the host is written into the erased flash memory blocks. Do not write to unerased blocks.




 Program execution state

Figure 21.5 User Program Mode (Example)

Differences between Boot Mode and User Program Mode

| | Boot Mode | User Program Mode |
|------------------------------|------------------------|--|
| Entire memory erase | Yes | Yes |
| Block erase | No | Yes |
| Programming control program* | Program/program-verify | Erase/erase-verify Program/program-verify |

Note: * To be provided by the user, in accordance with the recommended algorithm.

Block Configuration: The flash memory is divided into two 32-kbyte blocks (128-kbyte version only), two 8-kbyte blocks, one 16-kbyte block, one 28-kbyte block, and four 1-kbyte blocks.

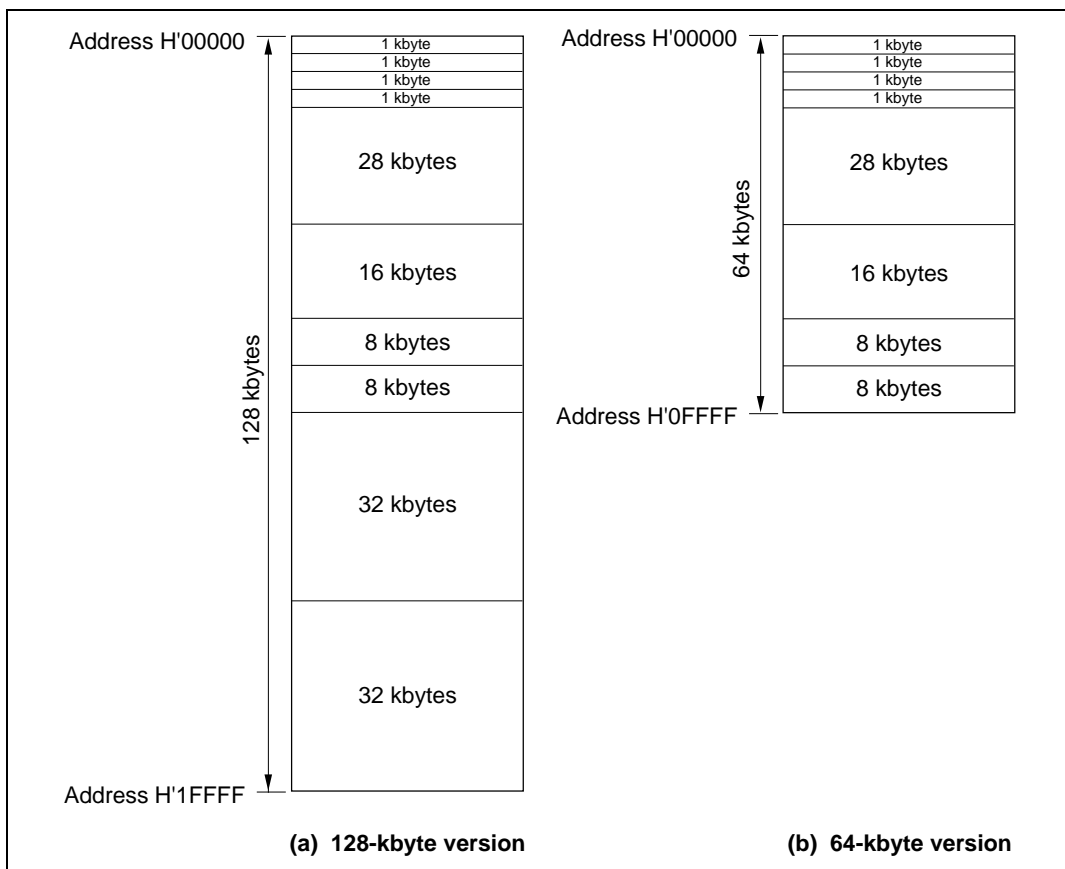


Figure 21.6 Flash Memory Block Configuration

21.4.4 Pin Configuration

The flash memory is controlled by means of the pins shown in table 21.3.

Table 21.3 Flash Memory Pins

| Pin Name | Abbreviation | I/O | Function |
|---------------|-------------------------|--------|--|
| Reset | $\overline{\text{RES}}$ | Input | Reset |
| Mode 1 | MD1 | Input | Sets MCU operating mode |
| Mode 0 | MD0 | Input | Sets MCU operating mode |
| Port 92 | P92 | Input | Sets MCU operating mode when MD1 = MD0 = 0 |
| Port 91 | P91 | Input | Sets MCU operating mode when MD1 = MD0 = 0 |
| Port 90 | P90 | Input | Sets MCU operating mode when MD1 = MD0 = 0 |
| Transmit data | TxD1 | Output | Serial transmit data output |
| Receive data | RxD1 | Input | Serial receive data input |

21.4.5 Register Configuration

The registers used to control the on-chip flash memory when enabled are shown in table 21.4. In order for these registers to be accessed, the FLSHE bit must be set to 1 in STCR.

Table 21.4 Flash Memory Registers

| Register Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|---------------------------------|----------------------|-------------------|--------------------|-----------------------|
| Flash memory control register 1 | FLMCR1 ^{*5} | R/W ^{*3} | H'80 | H'FF80 ^{*2} |
| Flash memory control register 2 | FLMCR2 ^{*5} | R/W ^{*3} | H'00 ^{*4} | H'FF81 ^{*2} |
| Erase block register 1 | EBR1 ^{*5} | R/W ^{*3} | H'00 ^{*4} | H'FF82 ^{*2} |
| Erase block register 2 | EBR2 ^{*5} | R/W ^{*3} | H'00 ^{*4} | H'FF83 ^{*2} |
| Serial timer control register | STCR | R/W | H'00 | H'FFC3 |

Notes: 1. Lower 16 bits of the address.

- Flash memory registers share addresses with other registers. Register selection is performed by the FLSHE bit in the serial timer control register (STCR).
- In modes in which the on-chip flash memory is disabled, a read will return H'00, and writes are invalid.
- The SWE bit in FLMCR1 is not set, these registers are initialized to H'00.
- FLMCR1, FLMCR2, EBR1, and EBR2 are 8-bit registers. Only byte accesses are valid for these registers, the access requiring 2 states. These registers are used only in the flash memory version. In the mask ROM version, a read at any of these addresses will return an undefined value, and writes are invalid.

21.5 Register Descriptions

21.5.1 Flash Memory Control Register 1 (FLMCR1)

| | | | | | | | | |
|---------------|-----|-----|---|---|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | FWE | SWE | — | — | EV | PV | E | P |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R/W | — | — | R/W | R/W | R/W | R/W |

FLMCR1 is an 8-bit register used for flash memory operating mode control. Program-verify mode or erase-verify mode is entered by setting SWE to 1. Program mode is entered by setting SWE to 1, then setting the PSU bit in FLMCR2, and finally setting the P bit. Erase mode is entered by setting SWE to 1, then setting the ESU bit in FLMCR2, and finally setting the E bit. FLMCR1 is initialized to H'80 by a reset, and in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode. When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

Writes to the EV and PV bits in FLMCR1 are enabled only when SWE=1; writes to the E bit only when SWE = 1, and ESU = 1; and writes to the P bit only when SWE = 1, and PSU = 1.

Bit 7—Flash Write Enable (FWE): Controls programming and erasing of the on-chip flash memory. This bit cannot be modified and is always read as 1.

Bit 6—Software Write Enable (SWE): Enables or disables flash memory programming. SWE should be set before setting bits ESU, PSU, EV, PV, E, P, and EB9 to EB0, and should not be cleared at the same time as these bits.

Bit 6

| SWE | Description |
|-----|---------------------------------|
| 0 | Writes disabled (Initial value) |
| 1 | Writes enabled |

Bits 5 and 4—Reserved: These bits cannot be modified and are always read as 0.

Bit 3—Erase-Verify (EV): Selects erase-verify mode transition or clearing. Do not set the SWE, ESU, PSU, PV, E, or P bit at the same time.

Bit 3

| EV | Description |
|----|--|
| 0 | Erase-verify mode cleared (Initial value) |
| 1 | Transition to erase-verify mode [Setting condition] When SWE = 1 |

Bit 2—Program-Verify (PV): Selects program-verify mode transition or clearing. Do not set the SWE, ESU, PSU, EV, E, or P bit at the same time.

Bit 2

| PV | Description |
|----|--|
| 0 | Program-verify mode cleared (Initial value) |
| 1 | Transition to program-verify mode [Setting condition] When SWE = 1 |

Bit 1—Erase (E): Selects erase mode transition or clearing. Do not set the SWE, ESU, PSU, EV, PV, or P bit at the same time.

Bit 1

| E | Description |
|---|--|
| 0 | Erase mode cleared (Initial value) |
| 1 | Transition to erase mode [Setting condition] When SWE = 1, and ESU = 1 |

Bit 0—Program (P): Selects program mode transition or clearing. Do not set the SWE, PSU, ESU, EV, PV, or E bit at the same time.

Bit 0

| P | Description |
|---|--|
| 0 | Program mode cleared (Initial value) |
| 1 | Transition to program mode [Setting condition] When SWE = 1, and PSU = 1 |

21.5.2 Flash Memory Control Register 2 (FLMCR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|-----|-----|
| | FLER | — | — | — | — | — | ESU | PSU |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | — | — | — | — | — | R/W | R/W |

FLMCR2 is an 8-bit register that monitors the presence or absence of flash memory program/erase protection (error protection) and performs setup for flash memory program/erase mode. FLMCR2 is initialized to H'00 by a reset, and in hardware standby mode. The ESU and PSU bits are cleared to 0 in software standby mode, subactive mode, subsleep mode, and watch mode.

When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

Bit 7—Flash Memory Error (FLER): Indicates that an error has occurred during an operation on flash memory (programming or erasing). When FLER is set to 1, flash memory goes to the error-protection state.

Bit 7

| FLER | Description |
|------|---|
| 0 | Flash memory is operating normally (Initial value) Flash memory program/erase protection (error protection) is disabled [Clearing condition] Reset or hardware standby mode |
| 1 | An error has occurred during flash memory programming/erasing Flash memory program/erase protection (error protection) is enabled [Setting condition] See section 21.8.3, Error Protection |

Bits 6 to 2—Reserved: Always write 0 when writing to these bits.

Bit 1—Erase Setup (ESU): Prepares for a transition to erase mode. Set this bit to 1 before setting the E bit to 1 in FLMCR1. Do not set the SWE, PSU, EV, PV, E, or P bit at the same time.

Bit 1

| ESU | Description |
|-----|--|
| 0 | Erase setup cleared (Initial value) |
| 1 | Erase setup [Setting condition] When SWE = 1 |

Bit 0—Program Setup (PSU): Prepares for a transition to program mode. Set this bit to 1 before setting the P bit to 1 in FLMCR1. Do not set the SWE, ESU, EV, PV, E, or P bit at the same time.

Bit 0

| PSU | Description |
|-----|--|
| 0 | Program setup cleared (Initial value) |
| 1 | Program setup [Setting condition] When SWE = 1 |

21.5.3 Erase Block Registers 1 and 2 (EBR1, EBR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|----------------------|----------------------|
| EBR1 | — | — | — | — | — | — | EB9/— ^{*2} | EB8/— ^{*2} |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | — | R/W ^{*1 *2} | R/W ^{*1 *2} |

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------------------|-----|-----|-----|-----|-----|-----|-----|
| EBR2 | EB7 | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W ^{*1} | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

- Notes:
1. In normal mode, these bits cannot be modified and are always read as 0.
 2. Bits EB8 and EB9 are not present in the 64-kbyte versions; These bits must not be set to 1.

EBR1 and EBR2 are registers that specify the flash memory erase area block by block; bits 1 and 2 in EBR1 (128 kB versions only) and bits 7 to 0 in EBR2 are readable/writable bits. EBR1 and EBR2 are each initialized to H'00 by a reset, in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode, and the SWE bit in FLMCR1 is not set. When a bit in EBR1 or EBR2 is set, the corresponding block can be erased. Other blocks are erase-protected. Set only one bit in EBR1 or EBR2 (more than one bit cannot be set). When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

The flash memory block configuration is shown in table 21.5.

Table 21.5 Flash Memory Erase Blocks

| Block (Size) | | Address |
|--------------------|-------------------|--------------------------|
| 128-kbyte Versions | 64-kbyte Versions | |
| EB0 (1 kbyte) | EB0 (1 kbyte) | H'(00)0000 to H'(00)03FF |
| EB1 (1 kbyte) | EB1 (1 kbyte) | H'(00)0400 to H'(00)07FF |
| EB2 (1 kbyte) | EB2 (1 kbyte) | H'(00)0800 to H'(00)0BFF |
| EB3 (1 kbyte) | EB3 (1 kbytes) | H'(00)0C00 to H'(00)0FFF |
| EB4 (28 kbytes) | EB4 (28 kbytes) | H'(00)1000 to H'(00)7FFF |
| EB5 (16 kbytes) | EB5 (16 kbytes) | H'(00)8000 to H'(00)BFFF |
| EB6 (8 kbytes) | EB6 (8 kbytes) | H'(00)C000 to H'(00)DFFF |
| EB7 (8 kbytes) | EB7 (8 kbytes) | H'00E000 to H'00FFFF |
| EB8 (32 kbytes) | — | H'010000 to H'017FFF |
| EB9 (32 kbytes) | — | H'018000 to H'01FFFF |

21.5.4 Serial Timer Control Register (STCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-------|-------|------|-------|-----|-------|-------|
| | — | IICX1 | IICX0 | IICE | FLSHE | — | ICKS1 | ICKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), and on-chip flash memory control (in F-ZTAT versions), and also selects the TCNT input clock. For details on functions not related to on-chip flash memory, see section 3.2.4, Serial Timer Control Register (STCR), and descriptions of individual modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Reserved: Do not write 1 to this bit.

Bits 6 to 4—I²C Control (IICX1, IICX0, IICE): When the on-chip IIC option is included, these bits control the operation of the I²C bus interface. For details, see section 16, I²C Bus Interface [H8S/2138 Group Option].

Bit 3—Flash Memory Control Register Enable (FLSHE): Setting the FLSHE bit to 1 enables read/write access to the flash memory control registers. If FLSHE is cleared to 0, the flash memory control registers are deselected. In this case, the flash memory control register contents are retained.

Bit 3

| FLSHE | Description |
|-------|---|
| 0 | Flash memory control registers deselected (Initial value) |
| 1 | Flash memory control registers selected |

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits control 8-bit timer operation. See section 12, 8-Bit Timers, for details.

21.6 On-Board Programming Modes

When pins are set to on-board programming mode, program/erase/verify operations can be performed on the on-chip flash memory. There are two on-board programming modes: boot mode and user program mode. The pin settings for transition to each of these modes are shown in table 21.6. For a diagram of the transitions to the various flash memory modes, see figure 21.3.

Only advanced mode setting is possible for boot mode.

In the case of user program mode, established in advanced mode or normal mode, depending on the setting of the MD0 pin. In normal mode, only programming of a 56-kbyte area of flash memory is possible.

Table 21.6 Setting On-Board Programming Modes

| Mode Name | Mode | | | | | |
|-------------------|--------------------|-----|-----|-----|-----|-----|
| | CPU Operating Mode | MD1 | MD0 | P92 | P91 | P90 |
| Boot mode | Advanced mode | 0 | 0 | 1* | 1* | 1* |
| User program mode | Advanced mode | 1 | 0 | — | — | — |
| | Normal mode | | 1 | — | — | — |

Note: * Can be used as I/O ports after boot mode is initiated.

21.6.1 Boot Mode

When boot mode is used, the flash memory programming control program must be prepared in the host beforehand. The channel 1 SCI to be used is set to asynchronous mode.

When a reset-start is executed after the H8S/2138 or H8S/2134 Group MCU's pins have been set to boot mode, the boot program built into the MCU is started and the programming control program prepared in the host is serially transmitted to the MCU via the SCI. In the MCU, the programming control program received via the SCI is written into the programming control program area in on-chip RAM. After the transfer is completed, control branches to the start address of the programming control program area and the programming control program execution state is entered (flash memory programming is performed).

The transferred programming control program must therefore include coding that follows the programming algorithm given later.

The system configuration in boot mode is shown in figure 21.7, and the boot program mode execution procedure in figure 21.8.

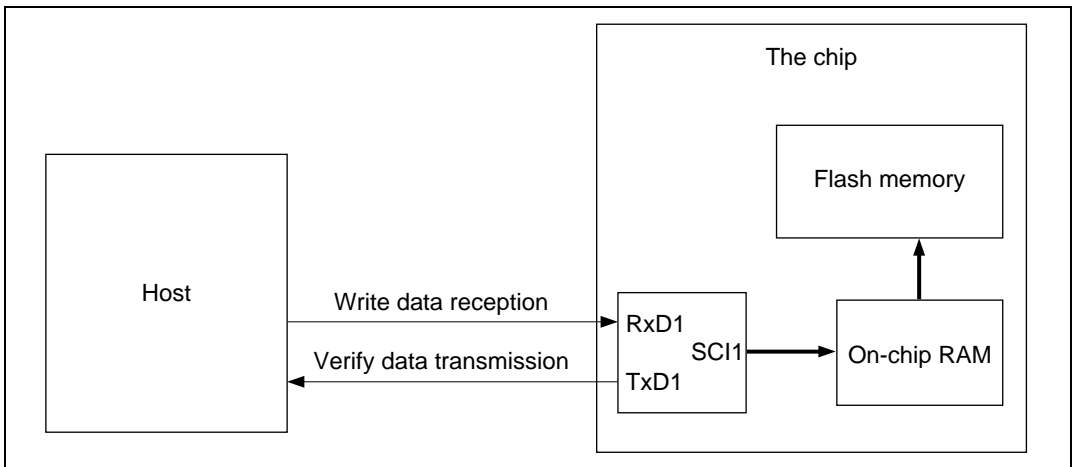


Figure 21.7 System Configuration in Boot Mode

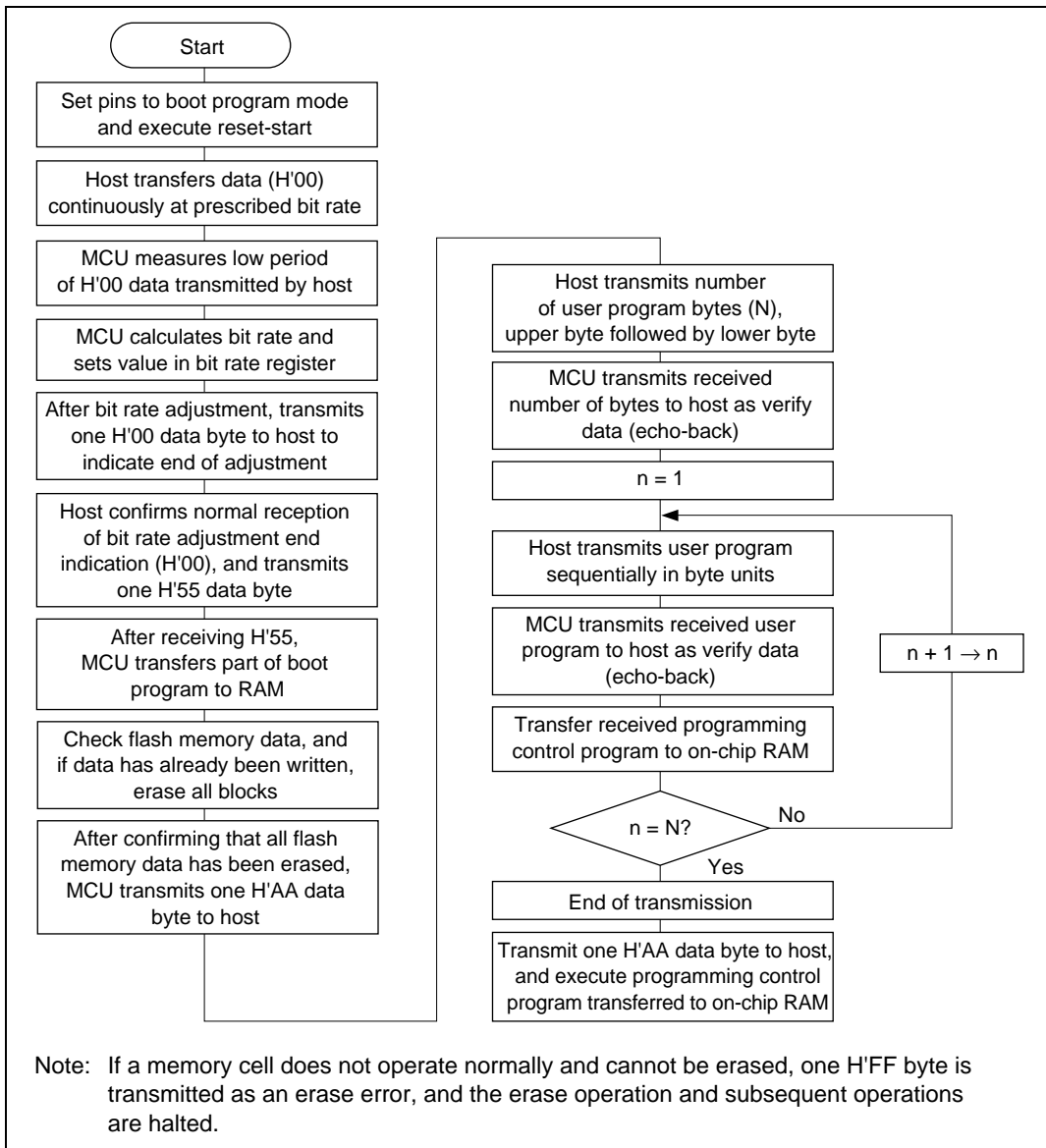


Figure 21.8 Boot Mode Execution Procedure

Automatic SCI Bit Rate Adjustment

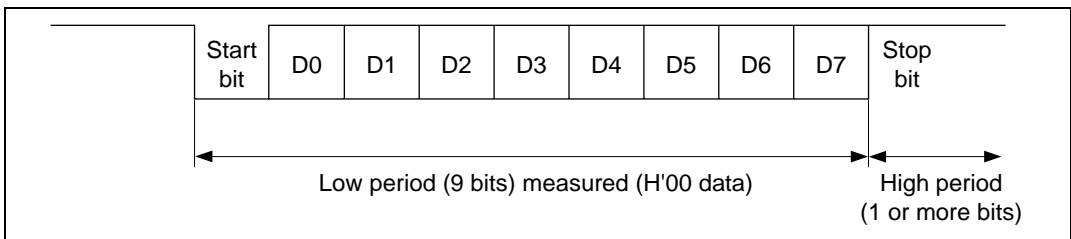


Figure 21.9 Rx/D1 Input Signal When Using Automatic SCI Bit Rate Adjustment

When boot mode is initiated, the H8S/2138 or H8S/2134 Group MCU measures the low period of the asynchronous SCI communication data (H'00) transmitted continuously from the host. The SCI transmit/receive format should be set as follows: 8-bit data, 1 stop bit, no parity. The MCU calculates the bit rate of the transmission from the host from the measured low period, and transmits one H'00 byte to the host to indicate the end of bit rate adjustment. The host should confirm that this adjustment end indication (H'00) has been received normally, and transmit one H'55 byte to the MCU. If reception cannot be performed normally, initiate boot mode again (reset), and repeat the above operations. Depending on the host's transmission bit rate and the MCU's system clock frequency, there will be a discrepancy between the bit rates of the host and the MCU. To ensure correct SCI operation, the host's transfer bit rate should be set to (2400, 4800, or 9600) bps.

Table 21.7 shows typical host transfer bit rates and system clock frequencies for which automatic adjustment of the MCU's bit rate is possible. The boot program should be executed within this system clock range.

Table 21.7 System Clock Frequencies for which Automatic Adjustment of H8S/2138 or H8S/2134 Group Bit Rate Is Possible

| Host Bit Rate | System Clock Frequency for which Automatic Adjustment of H8S/2138 or H8S/2134 Group Bit Rate Is Possible |
|---------------|--|
| 9600 bps | 8 MHz to 20 MHz |
| 4800 bps | 4 MHz to 20 MHz |
| 2400 bps | 2 MHz to 18 MHz |

On-Chip RAM Area Divisions in Boot Mode: In boot mode, the 128-byte area from H'(FF)FF00 to H'(FF)FF7F is reserved for use by the boot program, as shown in figure 21.10. The area to which the programming control program is transferred is H'(FF)E080 to H'(FF)EFFF (3968 bytes) in the 128-kbyte versions including H8S/2132, except for H8S/2132R or H'(FF)E880 to H'(FF)EFFF (1920 bytes) in the 64-kbyte versions including H8S/2132R, except for H8S/2132. The boot program area can be used when the programming control program transferred into RAM enters the execution state. A stack area should be set up as required.

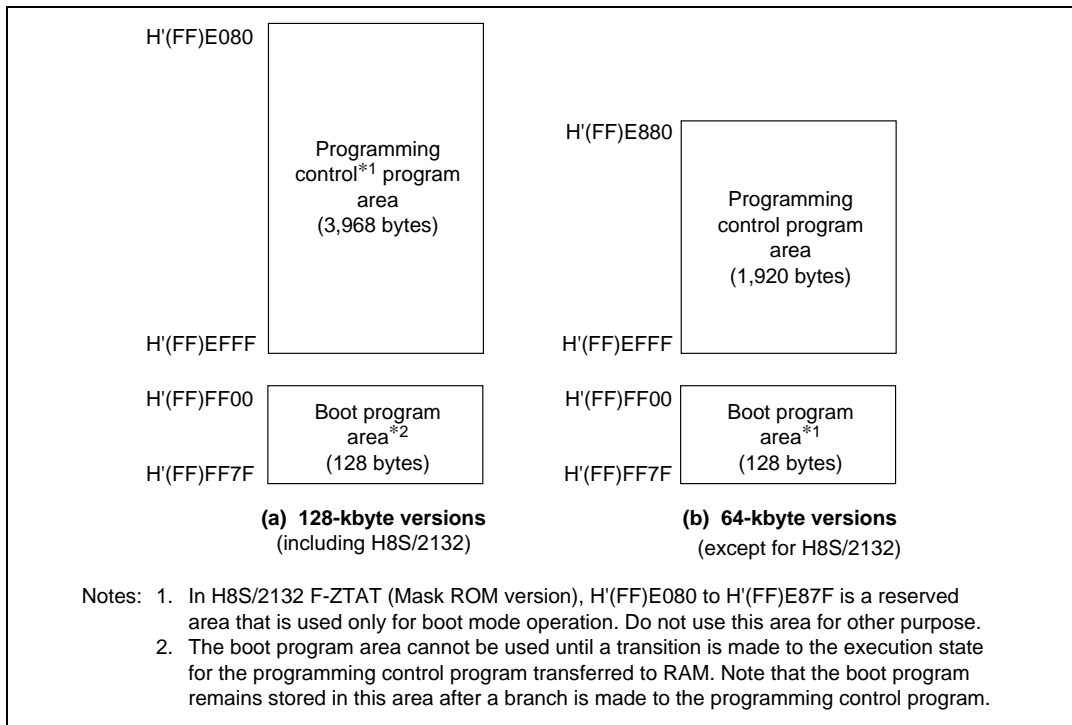


Figure 21.10 RAM Areas in Boot Mode

Notes on Use of User Mode:

- When the chip comes out of reset in boot mode, it measures the low period of the input at the SCI's RxD1 pin. The reset should end with RxD1 high. After the reset ends, it takes about 100 states for the chip to get ready to measure the low period of the RxD1 input.
- In boot mode, if any data has been programmed into the flash memory (if all data is not 1), all flash memory blocks are erased. Boot mode is for use when user program mode is unavailable, such as the first time on-board programming is performed, or if the program activated in user program mode is accidentally erased.

- Interrupts cannot be used while the flash memory is being programmed or erased.
- The Rx/D1 and Tx/D1 pins should be pulled up on the board.
- Before branching to the programming control program (RAM area H'(FF)E080 (128-kbyte versions including H8S/2132, except for H8S/2132R or H'(FF)E880 (64-kbyte versions, including H8S/2132R, except for H8S/2132)), the chip terminates transmit and receive operations by the on-chip SCI (channel 1) (by clearing the RE and TE bits in SCR to 0), but the adjusted bit rate value remains set in BRR. The transmit data output pin, Tx/D1, goes to the high-level output state (P84DDR = 1, P84DR = 1).

The contents of the CPU's internal general registers are undefined at this time, so these registers must be initialized immediately after branching to the programming control program. In particular, since the stack pointer (SP) is used implicitly in subroutine calls, etc., a stack area must be specified for use by the programming control program.

The initial values of other on-chip registers are not changed.

- Boot mode can be entered by making the pin settings shown in table 21.6 and executing a reset-start.

When the chip detects the boot mode setting at reset release^{*1}, P92, P91, and P90 can be used as I/O ports.

Boot mode can be cleared by driving the reset pin low, waiting at least 20 states, then setting the mode pins, and executing reset release^{*1}. Boot mode can also be cleared by a WDT overflow reset.

The mode pin input levels must not be changed in boot mode.

- If the mode pin input levels are changed (for example, from low to high) during a reset, the state of ports with multiplexed address functions and bus control output pins (\overline{AS} , \overline{RD} , \overline{WR}) will change according to the change in the microcomputer's operating mode^{*2}. Therefore, care must be taken to make pin settings to prevent these pins from becoming output signal pins during a reset, or to prevent collision with signals outside the microcomputer.

- Notes:
1. Mode pin input must satisfy the mode programming setup time ($t_{MDS} = 4$ states) with respect to the reset release timing.
 2. Ports with multiplexed address functions will output a low level as the address signal if mode pin setting is for mode 1 is entered during a reset. In other modes, the port pins go to the high-impedance state. The bus control output signals will output a high level if mode pin setting is for mode 1 is entered during a reset. In other modes, the port pins go to the high-impedance state.

21.6.2 User Program Mode

When set to user program mode, the chip can program and erase its flash memory by executing a user program/erase control program. Therefore, on-board reprogramming of the on-chip flash memory can be carried out by providing on-board supply of programming data, and storing a program/erase control program in part of the program area as necessary.

To select user program mode, select a mode that enables the on-chip flash memory (mode 2 or 3). In this mode, on-chip supporting modules other than flash memory operate as they normally would in mode 2 and 3.

The flash memory itself cannot be read while the SWE bit is set to 1 to perform programming or erasing, so the control program that performs programming and erasing should be run in on-chip RAM or external memory.

Figure 21.11 shows the procedure for executing the program/erase control program when transferred to on-chip RAM.

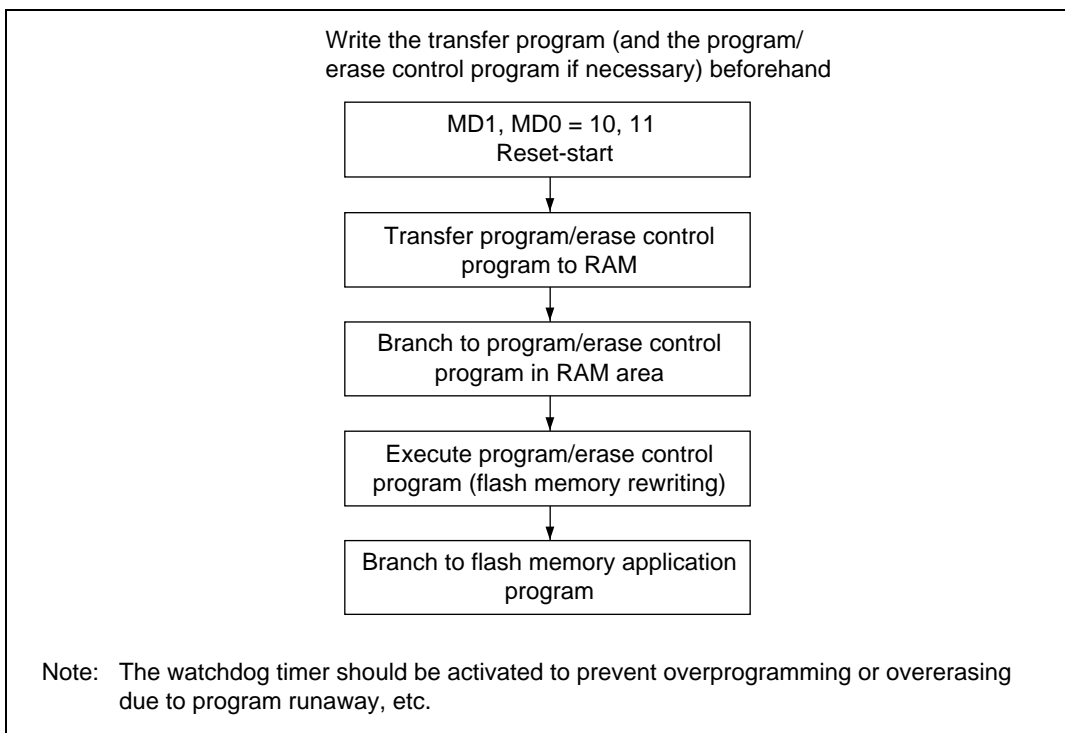


Figure 21.11 User Program Mode Execution Procedure

21.7 Programming/Erasing Flash Memory

In the on-board programming modes, flash memory programming and erasing is performed by software, using the CPU. There are four flash memory operating modes: program mode, erase mode, program-verify mode, and erase-verify mode. Transitions to these modes can be made by setting the PSU and ESU bits in FLMCR2, and the P, E, PV, and EV bits in FLMCR1.

The flash memory cannot be read while being programmed or erased. Therefore, the program that controls flash memory programming/erasing (the programming control program) should be located and executed in on-chip RAM or external memory.

- Notes:
1. Operation is not guaranteed if setting/resetting of the SWE, EV, PV, E, and P bits in FLMCR1, and the ESU and PSU bits in FLMCR2, is executed by a program in flash memory.
 2. Perform programming in the erased state. Do not perform additional programming on previously programmed addresses.

21.7.1 Program Mode

Follow the procedure shown in the program/program-verify flowchart in figure 21.12 to write data or programs to flash memory. Performing program operations according to this flowchart will enable data or programs to be written to flash memory without subjecting the device to voltage stress or sacrificing program data reliability. Programming should be carried out 32 bytes at a time.

The wait times (x , y , z , α , β , γ , ϵ , η) after setting/clearing individual bits in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the maximum number of writes (N) are shown in section 25, Electrical Characteristics, Flash Memory Characteristics.

Following the elapse of (x) μ s or more after the SWE bit is set to 1 in flash memory control register 1 (FLMCR1), 32-byte program data is stored in the program data area and reprogram data area, and the 32-byte data in the reprogram data area written consecutively to the write addresses. The lower 8 bits of the first address written to must be H'00, H'20, H'40, H'60, H'80, H'A0, H'C0, or H'E0. Thirty-two consecutive byte data transfers are performed. The program address and program data are latched in the flash memory. A 32-byte data transfer must be performed even if writing fewer than 32 bytes; in this case, H'FF data must be written to the extra addresses.

Next, the watchdog timer is set to prevent overprogramming in the event of program runaway, etc. Set a value greater than $(y + z + \alpha + \beta)$ μ s as the WDT overflow period. After this, preparation for program mode (program setup) is carried out by setting the PSU bit in FLMCR2, and after the elapse of (y) μ s or more, the operating mode is switched to program mode by setting the P bit in

FLMCR1. The time during which the P bit is set is the flash memory programming time. Make a program setting so that the time for one programming operation is within the range of (z) μ s.

21.7.2 Program-Verify Mode

In program-verify mode, the data written in program mode is read to check whether it has been correctly written in the flash memory.

After the elapse of a given programming time, the programming mode is exited (the P bit in FLMCR1 is cleared, then the PSU bit in FLMCR2 is cleared at least (α) μ s later). The watchdog timer is cleared after the elapse of (β) μ s or more, and the operating mode is switched to program-verify mode by setting the PV bit in FLMCR1. Before reading in program-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) μ s or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) μ s after the dummy write before performing this read operation. Next, the originally written data is compared with the verify data, and reprogram data is computed (see figure 21.12) and transferred to the reprogram data area. After 32 bytes of data have been verified, exit program-verify mode, wait for at least (η) μ s, then clear the SWE bit in FLMCR1. If reprogramming is necessary, set program mode again, and repeat the program/program-verify sequence as before. However, ensure that the program/program-verify sequence is not repeated more than (N) times on the same bits.

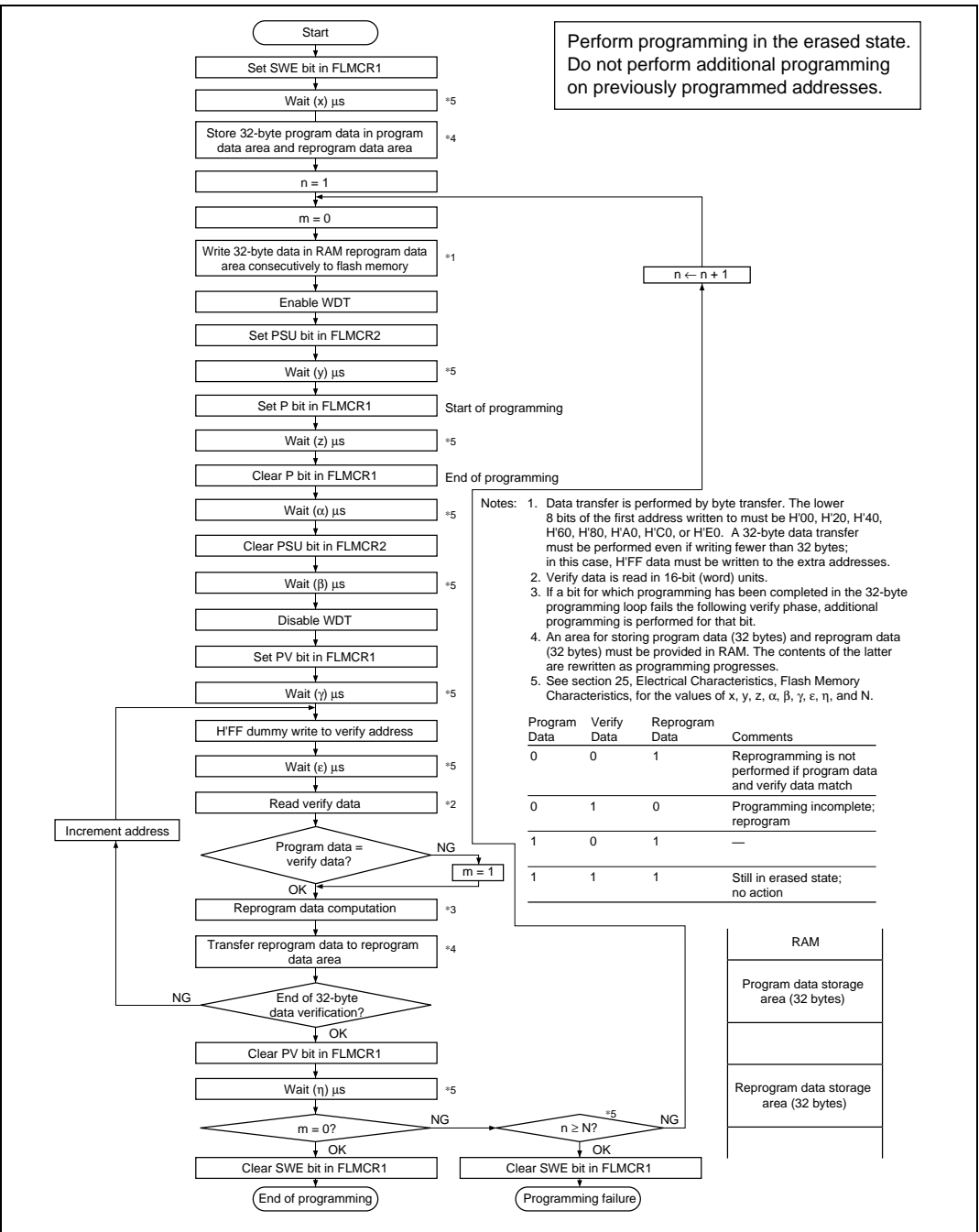


Figure 21.12 Program/Program-Verify Flowchart

21.7.3 Erase Mode

Flash memory erasing should be performed block by block following the procedure shown in the erase/erase-verify flowchart (single-block erase) shown in figure 21.13.

The wait times (x , y , z , α , β , γ , ϵ , η) after setting/clearing individual bits in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the maximum number of erases (N) are shown in section 25, Electrical Characteristics, Flash Memory Characteristics.

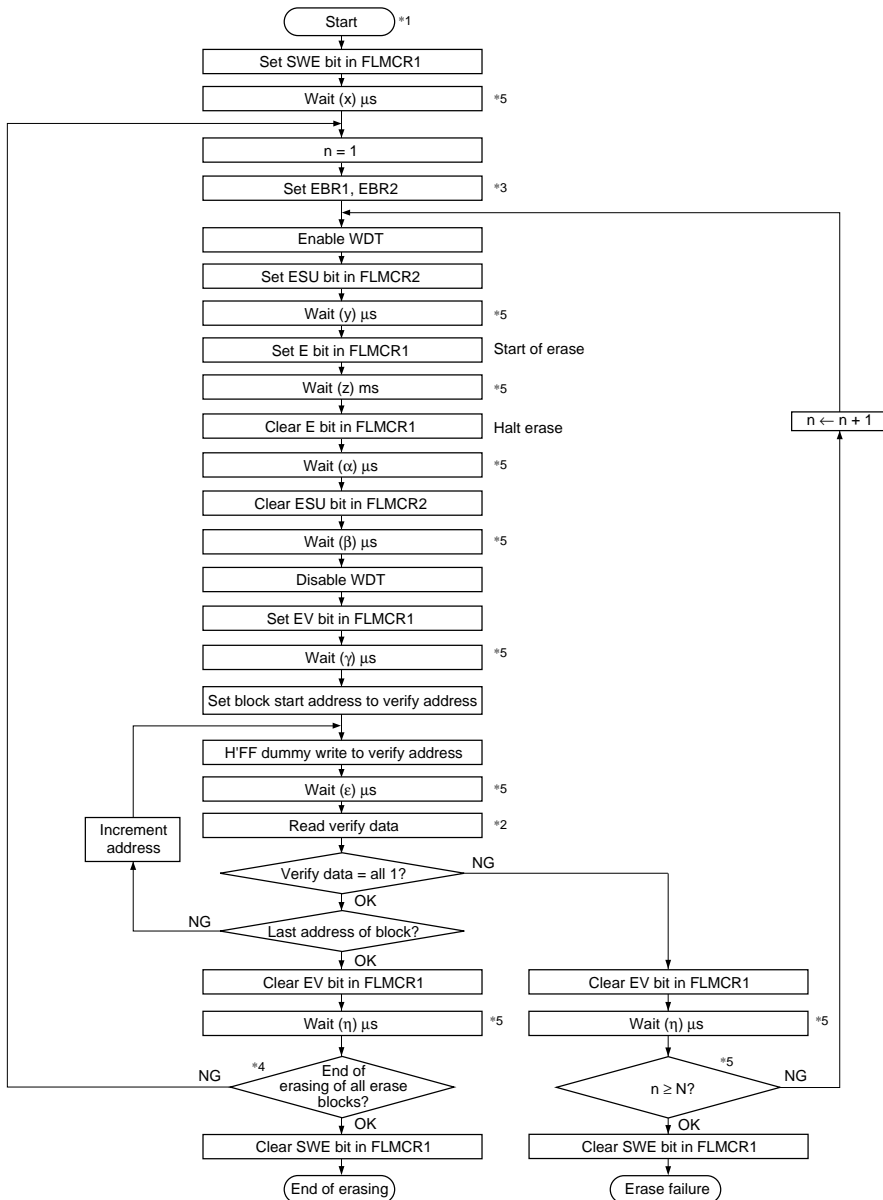
To perform data or program erasure, make a 1 bit setting for the flash memory area to be erased in erase block register 1 or 2 (EBR1 or EBR2) at least (x) μ s after setting the SWE bit to 1 in flash memory control register 1 (FLMCR1). Next, the watchdog timer is set to prevent overerasing in the event of program runaway, etc. Set a value greater than ($y + z + \alpha + \beta$) ms as the WDT overflow period. After this, preparation for erase mode (erase setup) is carried out by setting the ESU bit in FLMCR2, and after the elapse of (y) μ s or more, the operating mode is switched to erase mode by setting the E bit in FLMCR1. The time during which the E bit is set is the flash memory erase time. Ensure that the erase time does not exceed (z) ms.

Note: With flash memory erasing, preprogramming (setting all data in the memory to be erased to 0) is not necessary before starting the erase procedure.

21.7.4 Erase-Verify Mode

In erase-verify mode, data is read after memory has been erased to check whether it has been correctly erased.

After the elapse of the erase time, erase mode is exited (the E bit in FLMCR1 is cleared, then the ESU bit in FLMCR2 is cleared at least (α) μ s later), the watchdog timer is cleared after the elapse of (β) μ s or more, and the operating mode is switched to erase-verify mode by setting the EV bit in FLMCR1. Before reading in erase-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) μ s or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) μ s after the dummy write before performing this read operation. If the read data has been erased (all 1), a dummy write is performed to the next address, and erase-verify is performed. If the read data has not been erased, set erase mode again, and repeat the erase/erase-verify sequence in the same way. However, ensure that the erase/erase-verify sequence is not repeated more than (N) times. When verification is completed, exit erase-verify mode, and wait for at least (η) μ s. If erasure has been completed on all the erase blocks, clear the SWE bit in FLMCR1. If there are any unerased blocks, make a 1 bit setting in EBR1 or EBR2 for the flash memory area to be erased, and repeat the erase/erase-verify sequence in the same way.



- Notes:
1. Preprogramming (setting erase block data to all 0) is not necessary.
 2. Verify data is read in 16-bit (W) units.
 3. Set only one bit in EBR1 or EBR2. More than one bit cannot be set.
 4. Erasing is performed in block units. To erase a number of blocks, the individual blocks must be erased sequentially.
 5. See section 25, Electrical Characteristics, Flash Memory Characteristics, for the values of x, y, z, α, β, γ, ε, η, and N.

Figure 21.13 Erase/Erase-Verify Flowchart (Single-Block Erase)

21.8 Flash Memory Protection

There are three kinds of flash memory program/erase protection: hardware protection, software protection, and error protection.

21.8.1 Hardware Protection

Hardware protection refers to a state in which programming/erasing of flash memory is forcibly disabled or aborted. Hardware protection is reset by settings in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and erase block registers 1 and 2 (EBR1, EBR2). (See table 21.8.)

Table 21.8 Hardware Protection

| Item | Description | Functions | |
|--------------------------|--|-----------|-------|
| | | Program | Erase |
| Reset/standby protection | <ul style="list-style-type: none"> In a reset (including a WDT overflow reset), software standby mode, subactive mode, subsleep mode, and watch mode, FLMCR1, FLMCR2, EBR1, and EBR2 are initialized, and the program/erase-protected state is entered. In a reset via the $\overline{\text{RES}}$ pin, the reset state is not entered unless the $\overline{\text{RES}}$ pin is held low until oscillation stabilizes after powering on. In the case of a reset during operation, hold the $\overline{\text{RES}}$ pin low for the $\overline{\text{RES}}$ pulse width specified in the AC Characteristics section. | Yes | Yes |

21.8.2 Software Protection

Software protection can be implemented by setting the SWE bit in FLMCR1 and erase block registers 1 and 2 (EBR1, EBR2). When software protection is in effect, setting the P or E bit in flash memory control register 1 (FLMCR1) does not cause a transition to program mode or erase mode. (See table 21.9.)

Table 21.9 Software Protection

| Item | Description | Functions | |
|--------------------------------|---|-----------|-------|
| | | Program | Erase |
| SWE bit protection | <ul style="list-style-type: none"> Clearing the SWE bit to 0 in FLMCR1 sets the program/erase-protected state for all blocks. (Execute in on-chip RAM or external memory.) | Yes | Yes |
| Block specification protection | <ul style="list-style-type: none"> Erase protection can be set for individual blocks by settings in erase block registers 1 and 2 (EBR1, EBR2). Setting EBR1 and EBR2 to H'00 places all blocks in the erase-protected state. | — | Yes |

21.8.3 Error Protection

In error protection, an error is detected when MCU runaway occurs during flash memory programming/erasing, or operation is not performed in accordance with the program/erase algorithm, and the program/erase operation is aborted. Aborting the program/erase operation prevents damage to the flash memory due to overprogramming or overerasing.

If the MCU malfunctions during flash memory programming/erasing, the FLER bit is set to 1 in FLMCR2 and the error protection state is entered. The FLMCR1, FLMCR2, EBR1, and EBR2 settings are retained, but program mode or erase mode is aborted at the point at which the error occurred. Program mode or erase mode cannot be re-entered by re-setting the P or E bit. However, PV and EV bit setting is enabled, and a transition can be made to verify mode.

FLER bit setting conditions are as follows:

- When flash memory is read during programming/erasing (including a vector read or instruction fetch)
- Immediately after exception handling (excluding a reset) during programming/erasing
- When a SLEEP instruction (transition to software standby, sleep, subactive, subsleep, or watch mode) is executed during programming/erasing
- When the bus is released during programming/erasing

Error protection is released only by a reset and in hardware standby mode.

Figure 21.14 shows the flash memory state transition diagram.

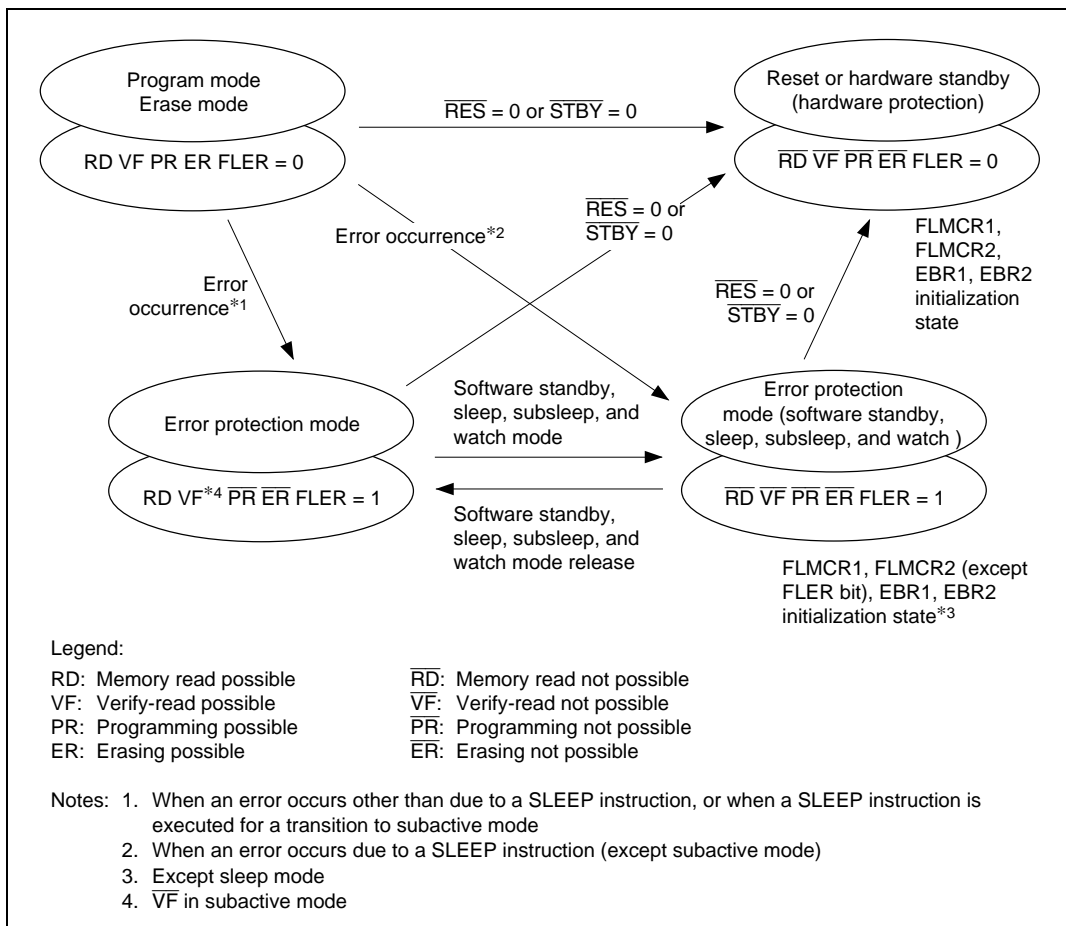


Figure 21.14 Flash Memory State Transitions

21.9 Interrupt Handling when Programming/Erasing Flash Memory

All interrupts, including NMI input is disabled when flash memory is being programmed or erased (when the P or E bit is set in FLMCR1), and while the boot program is executing in boot mode^{*1}, to give priority to the program or erase operation. There are three reasons for this:

1. Interrupt during programming or erasing might cause a violation of the programming or erasing algorithm, with the result that normal operation could not be assured.
2. In the interrupt exception handling sequence during programming or erasing, the vector would not be read correctly^{*2}, possibly resulting in MCU runaway.
3. If interrupt occurred during boot program execution, it would not be possible to execute the normal boot mode sequence.

For these reasons, in on-board programming mode alone there are conditions for disabling interrupt, as an exception to the general rule. However, this provision does not guarantee normal erasing and programming or MCU operation. All interrupt requests, including NMI input, must therefore be disabled inside and outside the MCU when programming or erasing flash memory. Interrupt is also disabled in the error-protection state while the P or E bit remains set in FLMCR1.

- Notes:
1. Interrupt requests must be disabled inside and outside the MCU until the programming control program has completed programming.
 2. The vector may not be read correctly in this case for the following two reasons:
 - If flash memory is read while being programmed or erased (while the P or E bit is set in FLMCR1), correct read data will not be obtained (undetermined values will be returned).
 - If the interrupt entry in the vector table has not been programmed yet, interrupt exception handling will not be executed correctly.

21.10 Flash Memory Programmer Mode

21.10.1 Programmer Mode Setting

Programs and data can be written and erased in programmer mode as well as in the on-board programming modes. In programmer mode, the on-chip ROM can be freely programmed using a PROM programmer that supports Renesas Technology microcomputer device types with 128-kbyte^{*1 *3} or 64-kbyte^{*2 *3} on-chip flash memory. Flash memory read mode, auto-program mode, auto-erase mode, and status read mode are supported with these device types. In auto-program mode, auto-erase mode, and status read mode, a status polling procedure is used, and in status read mode, detailed internal signals are output after execution of an auto-program or auto-erase operation.

Table 21.10 shows programmer mode pin settings.

- Notes:
1. Applies to the H8S/2138 and H8S/2134
 2. Applies to the H8S/2132.
 3. Use products other than the A-mask version of the H8S/2138, H8S/2134, and H8S/2132 (in either 5-V or 3-V version) with the writing voltage for the PROM programmer set to 5.0 V. Do not use the A-mask version with a 5.0-V PROM programmer setting.

Table 21.10 Programmer Mode Pin Settings

| Pin Names | Setting/External Circuit Connection |
|---|---|
| Mode pins: MD1, MD0 | Low-level input to MD1, MD0 |
| STBY pin | High-level input (Hardware standby mode not set) |
| RES pin | Power-on reset circuit |
| XTAL and EXTAL pins | Oscillation circuit |
| Other setting pins: P97, P92, P91, P90, P67 | Low-level input to P92, P67, high-level input to P97, P91, P90 |

21.10.2 Socket Adapters and Memory Map

In programmer mode, a socket adapter is mounted on the writer programmer to match the package concerned. Socket adapters are available for each writer manufacturer supporting Renesas Technology microcomputer device types with 128-kbyte or 64-kbyte on-chip flash memory.

Figure 21.15 shows the memory map in programmer mode. For pin names in programmer mode, see section 1.3.2, Pin Functions in Each Operating Mode.

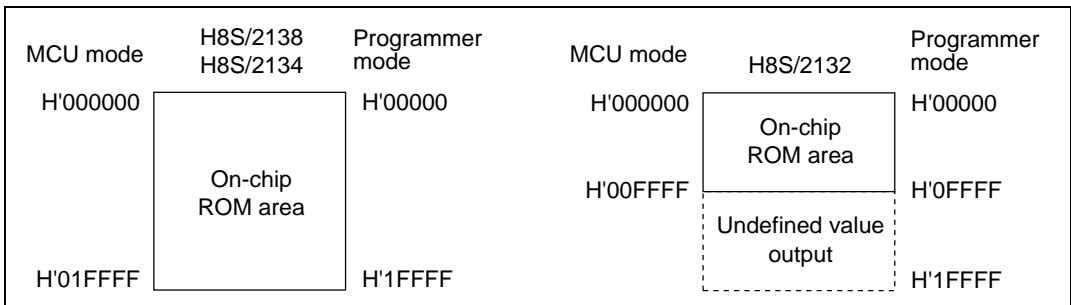


Figure 21.15 Memory Map in Programmer Mode

21.10.3 Programmer Mode Operation

Table 21.11 shows how the different operating modes are set when using programmer mode, and table 21.12 lists the commands used in programmer mode. Details of each mode are given below.

- **Memory Read Mode**
Memory read mode supports byte reads.
- **Auto-Program Mode**
Auto-program mode supports programming of 128 bytes at a time. Status polling is used to confirm the end of auto-programming.
- **Auto-Erase Mode**
Auto-erase mode supports automatic erasing of the entire flash memory. Status polling is used to confirm the end of auto-erasing.
- **Status Read Mode**
Status polling is used for auto-programming and auto-erasing, and normal termination can be confirmed by reading the FO6 signal. In status read mode, error information is output if an error occurs.

Table 21.11 Settings for Each Operating Mode in Programmer Mode

| Mode | Pin Names | | | | |
|----------------------------|-----------------|-----------------|-----------------|-------------|-------------------|
| | \overline{CE} | \overline{OE} | \overline{WE} | FO7 to FO0 | FA17 to FA0 |
| Read | L | L | H | Data output | Ain ^{*2} |
| Output disable | L | H | H | Hi-Z | X |
| Command write | L | H | L | Data input | Ain ^{*2} |
| Chip disable ^{*1} | H | X | X | Hi-Z | X |

Notes: 1. Chip disable is not a standby state; internally, it is an operation state.

2. Ain indicates that there is also address input in auto-program mode.

Table 21.12 Programmer Mode Commands

| Command Name | Number of Cycles | 1st Cycle | | | 2nd Cycle | | |
|-------------------|------------------|-----------|---------|------|-----------|---------|------|
| | | Mode | Address | Data | Mode | Address | Data |
| Memory read mode | 1 + n | Write | X | H'00 | Read | RA | Dout |
| Auto-program mode | 129 | Write | X | H'40 | Write | WA | Din |
| Auto-erase mode | 2 | Write | X | H'20 | Write | X | H'20 |
| Status read mode | 2 | Write | X | H'71 | Write | X | H'71 |

Notes: 1. In auto-program mode, 129 cycles are required for command writing by a simultaneous 128-byte write.

2. In memory read mode, the number of cycles depends on the number of address write cycles (n).

21.10.4 Memory Read Mode

- After the end of an auto-program, auto-erase, or status read operation, the command wait state is entered. To read memory contents, a transition must be made to memory read mode by means of a command write before the read is executed.
- Command writes can be performed in memory read mode, just as in the command wait state.
- Once memory read mode has been entered, consecutive reads can be performed.
- After power-on, memory read mode is entered.

Table 21.13 AC Characteristics in Memory Read ModeConditions: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|------------|-----|-----|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

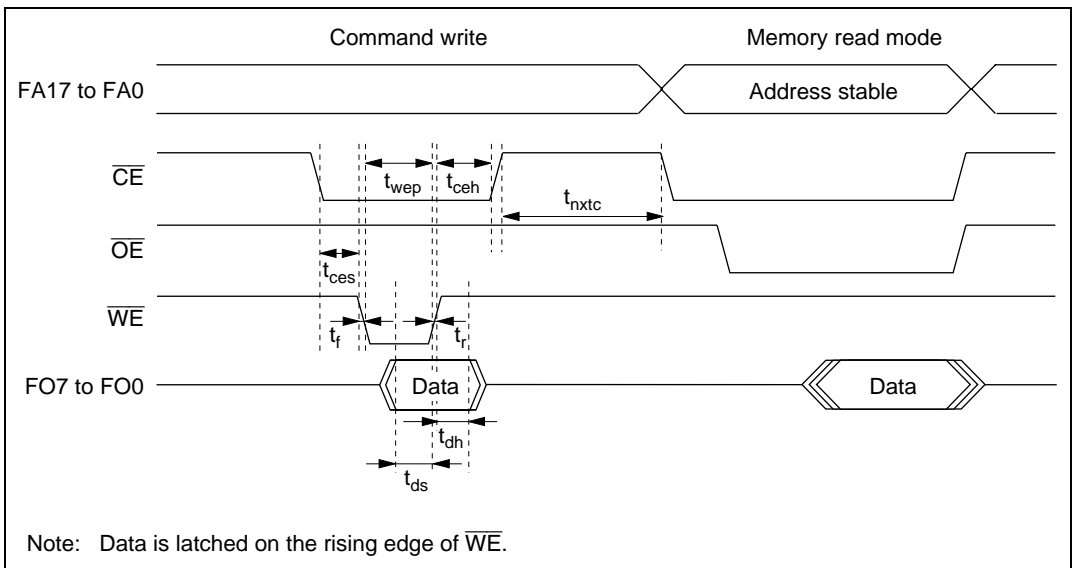
**Figure 21.16 Memory Read Mode Timing Waveforms after Command Write**

Table 21.14 AC Characteristics When Entering Another Mode from Memory Read ModeConditions: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|------------|-----|-----|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

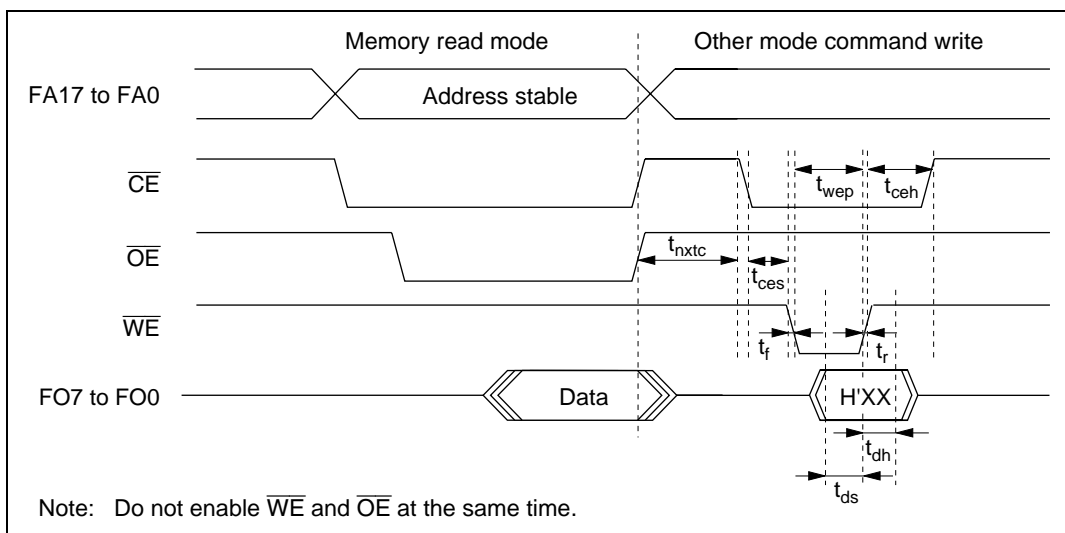
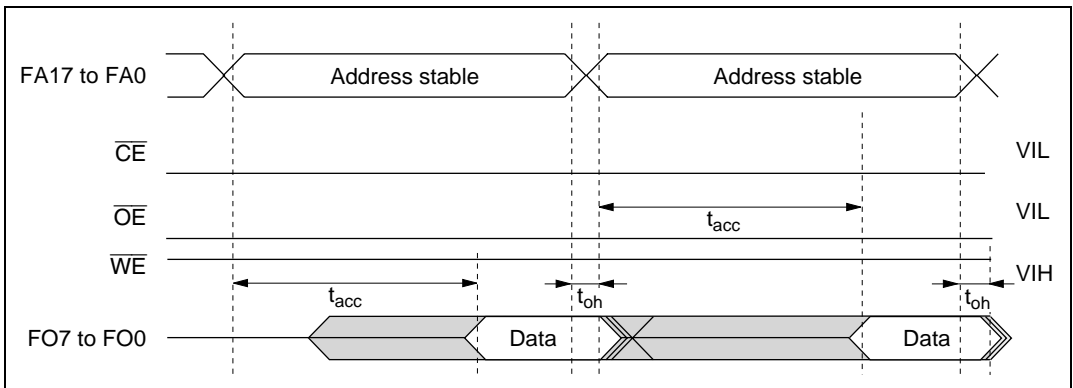
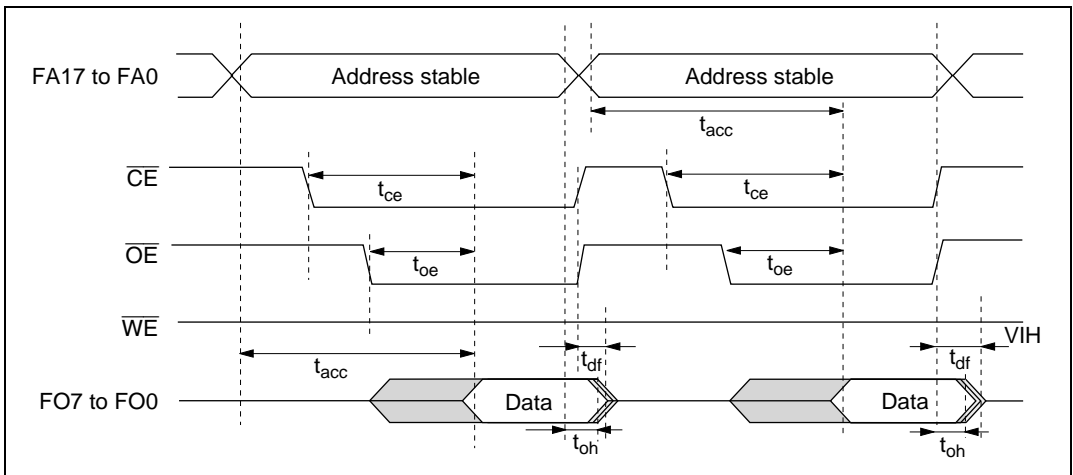
**Figure 21.17 Timing Waveforms When Entering Another Mode from Memory Read Mode**

Table 21.15 AC Characteristics in Memory Read ModeConditions: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|--|-----------|-----|-----|---------------|
| Access time | t_{acc} | — | 20 | μs |
| $\overline{\text{CE}}$ output delay time | t_{ce} | — | 150 | ns |
| $\overline{\text{OE}}$ output delay time | t_{oe} | — | 150 | ns |
| Output disable delay time | t_{df} | — | 100 | ns |
| Data output hold time | t_{oh} | 5 | — | ns |

**Figure 21.18 Timing Waveforms for $\overline{\text{CE}}/\overline{\text{OE}}$ Enable State Read****Figure 21.19 Timing Waveforms for $\overline{\text{CE}}/\overline{\text{OE}}$ Clocked Read**

21.10.5 Auto-Program Mode

AC Characteristics

Table 21.16 AC Characteristics in Auto-Program Mode

Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|-------------|-----|------|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| Status polling start time | t_{wsts} | 1 | — | ms |
| Status polling access time | t_{spa} | — | 150 | ns |
| Address setup time | t_{as} | 0 | — | ns |
| Address hold time | t_{ah} | 60 | — | ns |
| Memory write time | t_{write} | 1 | 3000 | ms |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

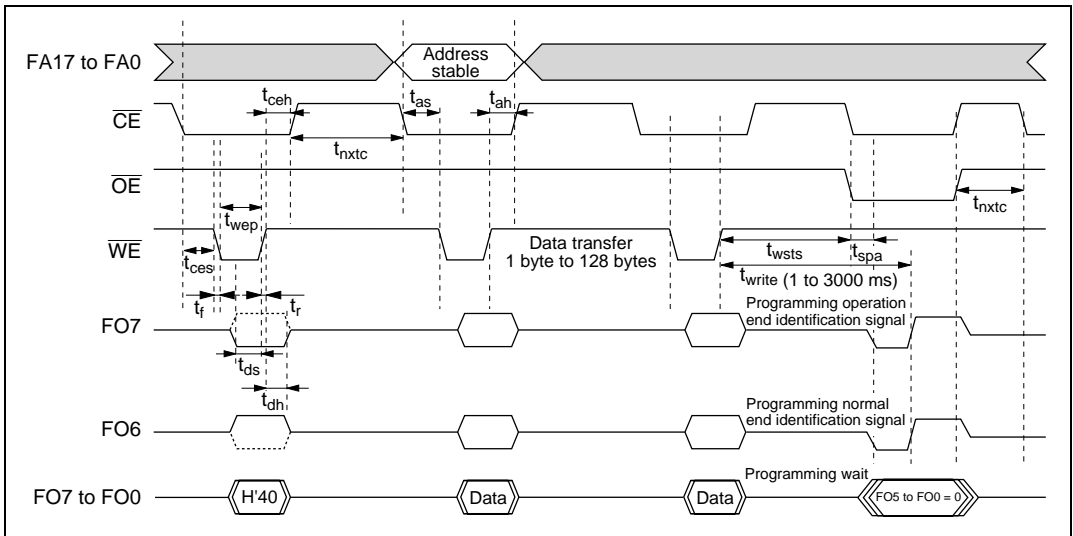


Figure 21.20 Auto-Program Mode Timing Waveforms

Notes on Use of Auto-Program Mode

- In auto-program mode, 128 bytes are programmed simultaneously. This should be carried out by executing 128 consecutive byte transfers.
- A 128-byte data transfer is necessary even when programming fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
- The lower 8 bits of the transfer address must be H'00 or H'80. If a value other than an effective address is input, processing will switch to a memory write operation but a write error will be flagged.
- Memory address transfer is performed in the second cycle (figure 21.20). Do not perform transfer after the second cycle.
- Do not perform a command write during a programming operation.
- Perform one auto-programming operation for a 128-byte block for each address. Characteristics are not guaranteed for two or more programming operations.
- Confirm normal end of auto-programming by checking FO6. Alternatively, status read mode can also be used for this purpose (FO7 status polling uses the auto-program operation end identification pin).
- The status polling FO6 and FO7 pin information is retained until the next command write. Until the next command write is performed, reading is possible by enabling CE and OE.

21.10.6 Auto-Erase Mode

AC Characteristics

Table 21.17 AC Characteristics in Auto-Erase Mode

Conditions: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|-------------|-----|-------|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| Status polling start time | t_{ests} | 1 | — | ms |
| Status polling access time | t_{spa} | — | 150 | ns |
| Memory erase time | t_{erase} | 100 | 40000 | ms |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

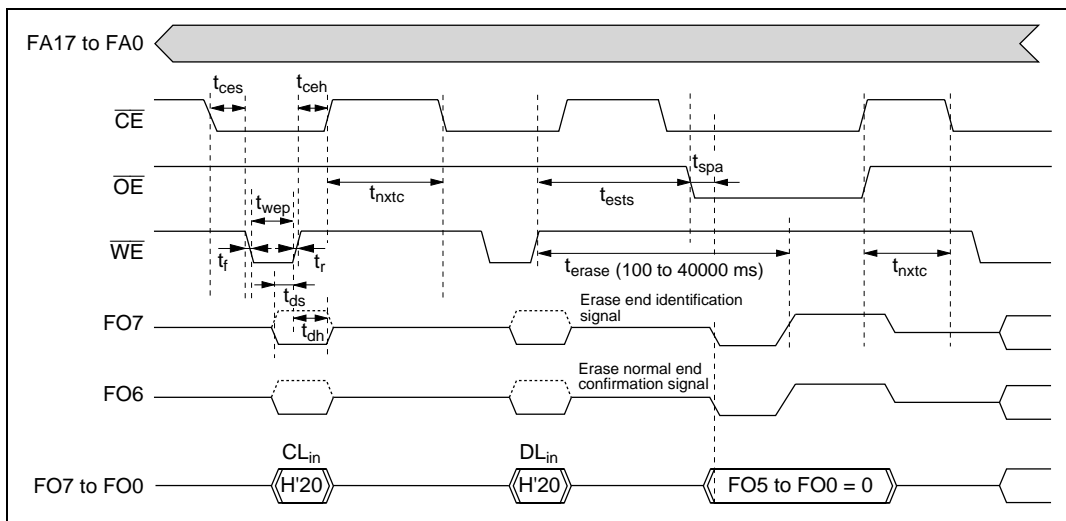


Figure 21.21 Auto-Erase Mode Timing Waveforms

Notes on Use of Erase-Program Mode

- Auto-erase mode supports only entire memory erasing.
- Do not perform a command write during auto-erasing.
- Confirm normal end of auto-erasing by checking FO6. Alternatively, status read mode can also be used for this purpose (FO7 status polling uses the auto-erase operation end identification pin).
- The status polling FO6 and FO7 pin information is retained until the next command write. Until the next command write is performed, reading is possible by enabling $\overline{\text{CE}}$ and $\overline{\text{OE}}$.

21.10.7 Status Read Mode

- Status read mode is used to identify what type of abnormal end has occurred. Use this mode when an abnormal end occurs in auto-program mode or auto-erase mode.
- The return code is retained until a command write for other than status read mode is performed.

Table 21.18 AC Characteristics in Status Read Mode

Conditions: $V_{\text{CC}} = 5.0 \text{ V} \pm 10\%$, $V_{\text{SS}} = 0 \text{ V}$, $T_{\text{a}} = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$

| Item | Symbol | Min | Max | Unit |
|--|-------------------|-----|-----|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| $\overline{\text{OE}}$ output delay time | t_{oe} | — | 150 | ns |
| Disable delay time | t_{df} | — | 100 | ns |
| $\overline{\text{CE}}$ output delay time | t_{ce} | — | 150 | ns |
| $\overline{\text{WE}}$ rise time | t_{r} | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_{f} | — | 30 | ns |

21.10.8 Status Polling

- The FO7 status polling flag indicates the operating status in auto-program or auto-erase mode.
- The FO6 status polling flag indicates a normal or abnormal end in auto-program or auto-erase mode.

Table 21.20 Status Polling Output Truth Table

| Pin Names | Internal Operation in Progress | Abnormal End | — | Normal End |
|------------|--------------------------------|--------------|---|------------|
| FO7 | 0 | 1 | 0 | 1 |
| FO6 | 0 | 0 | 1 | 1 |
| FO0 to FO5 | 0 | 0 | 0 | 0 |

21.10.9 Programmer Mode Transition Time

Commands cannot be accepted during the oscillation stabilization period or the programmer mode setup period. After the programmer mode setup time, a transition is made to memory read mode.

Table 21.21 Command Wait State Transition Time Specifications

| Item | Symbol | Min | Max | Unit |
|--|------------|-----|-----|------|
| Standby release (oscillation stabilization time) | t_{osc1} | 20 | — | ms |
| PROM mode setup time | t_{bmv} | 10 | — | ms |
| V_{cc} hold time | t_{dwn} | 0 | — | ms |

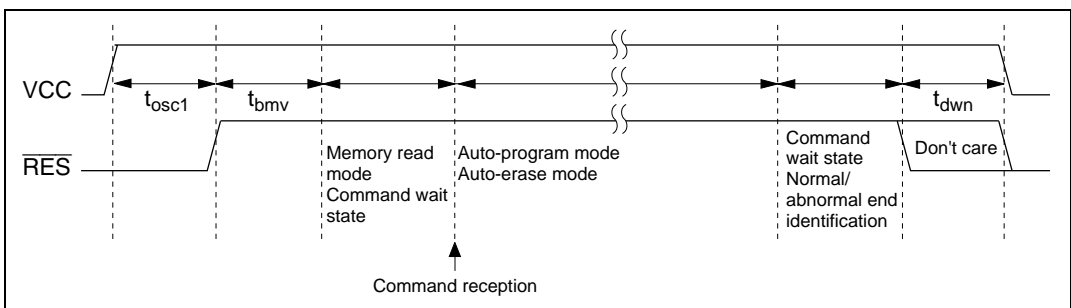


Figure 21.23 Oscillation Stabilization Time, Programmer Mode Setup Time, and Power Supply Fall Sequence

21.10.10 Notes on Memory Programming

- When programming addresses which have previously been programmed, carry out auto-erasing before auto-programming.
- When performing programming using programmer mode on a chip that has been programmed/erased in an on-board programming mode, auto-erasing is recommended before carrying out auto-programming.

Notes: 1. The flash memory is initially in the erased state when the device is shipped by Renesas. For other chips for which the erasure history is unknown, it is recommended that auto-erasing be executed to check and supplement the initialization (erase) level.

2. Auto-programming should be performed once only on the same address block.

21.11 Flash Memory Programming and Erasing Precautions

Precautions concerning the use of on-board programming mode and programmer mode are summarized below.

Use the specified voltages and timing for programming and erasing: Applied voltages in excess of the rating can permanently damage the device. For a PROM programmer, use Renesas Technology microcomputer device types with 128-kbyte or 64-kbyte on-chip flash memory that support a 5.0 V programming voltage.

Do not select the HN28F101 or use a programming voltage of 3.3 V for the PROM programmer, and only use the specified socket adapter. Incorrect use will result in damaging the device.

Powering on and off: When applying or disconnecting V_{cc} , fix the \overline{RES} pin low and place the flash memory in the hardware protection state.

The power-on and power-off timing requirements should also be satisfied in the event of a power failure and subsequent recovery.

Use the recommended algorithm when programming and erasing flash memory: The recommended algorithm enables programming and erasing to be carried out without subjecting the device to voltage stress or sacrificing program data reliability. When setting the P or E bit in FLMCR1, the watchdog timer should be set beforehand as a precaution against program runaway, etc.

Do not set or clear the SWE bit during program execution in flash memory: Clear the SWE bit before executing a program or reading data in flash memory. When the SWE bit is set, data in flash memory can be rewritten, but flash memory should only be accessed for verify operations (verification during programming/erasing).

Do not use interrupts while flash memory is being programmed or erased: All interrupt requests, including NMI, should be disabled to give priority to program/erase operations.

Do not perform additional programming. Erase the memory before reprogramming. In on-board programming, perform only one programming operation on a 32-byte programming unit block. In programmer mode, too, perform only one programming operation on a 128-byte programming unit block. Programming should be carried out with the entire programming unit block erased.

Before programming, check that the chip is correctly mounted in the PROM programmer. Overcurrent damage to the device can result if the index marks on the PROM programmer socket, socket adapter, and chip are not correctly aligned.

Do not touch the socket adapter or chip during programming. Touching either of these can cause contact faults and write errors.

21.12 Note on Switching from F-ZTAT Version to Mask ROM Version

The mask ROM version does not have the internal registers for flash memory control that are provided in the F-ZTAT version. Table 21.22 lists the registers that are present in the F-ZTAT version but not in the mask ROM version. If a register listed in table 21.22 is read in the mask ROM version, an undefined value will be returned. Therefore, if application software developed on the F-ZTAT version is switched to a mask ROM version product, it must be modified to ensure that the registers in table 21.22 have no effect.

Table 21.22 Registers Present in F-ZTAT Version but Absent in Mask ROM Version

| Register | Abbreviation | Address |
|---------------------------------|--------------|---------|
| Flash memory control register 1 | FLMCR1 | H'FF80 |
| Flash memory control register 2 | FLMCR2 | H'FF81 |
| Erase block register 1 | EBR1 | H'FF82 |
| Erase block register 2 | EBR2 | H'FF83 |

Section 22 ROM

(H8S/2138 F-ZTAT A-Mask Version, H8S/2134 F-ZTAT A-Mask Version)

22.1 Overview

H8S/2138 F-ZTAT A-mask version and H8S/2134 F-ZTAT A-mask version have 128 kbytes of on-chip flash memory. The flash memory is connected to the bus master by a 16-bit data bus. The bus master accesses both byte and word data in one state, enabling faster instruction fetches and higher processing speed.

The mode pins (MD1 and MD0) and the EXPE bit in MDCR can be set to enable or disable the on-chip ROM.

The flash memory version of this group can be erased and programmed on-board as well as with a general-purpose PROM programmer.

22.1.1 Block Diagram

Figure 22.1 shows a block diagram of the ROM.

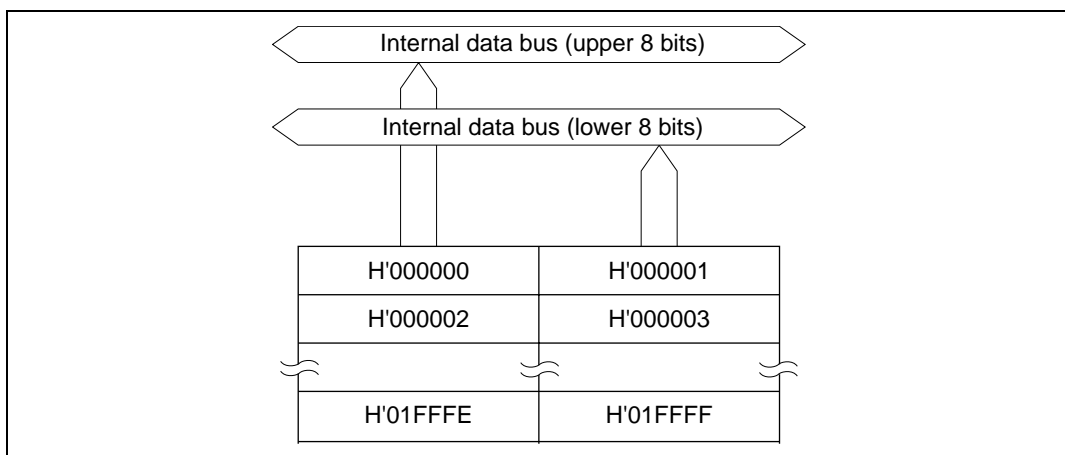


Figure 22.1 ROM Block Diagram

22.1.2 Register Configuration

This group on-chip ROM is controlled by the operating mode and register MDCR. The register configuration is shown in table 22.1.

Table 22.1 ROM Register

| Register Name | Abbreviation | R/W | Initial Value | Address* |
|-----------------------|--------------|-----|--|----------|
| Mode control register | MDCR | R/W | Undefined Depends on the operating mode | H'FFC5 |

Note: * Lower 16 bits of the address.

22.2 Register Descriptions

22.2.1 Mode Control Register (MDCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|------|------|
| | EXPE | — | — | — | — | — | MDS1 | MDS0 |
| Initial value | —* | 0 | 0 | 0 | 0 | 0 | —* | —* |
| Read/Write | R/W* | — | — | — | — | — | R | R |

Note: * Determined by the MD1 and MD0 pins.

MDCR is an 8-bit read-only register used to set this group operating mode and monitor the current operating mode.

The EXPE bit is initialized in accordance with the mode pin states by a reset and in hardware standby mode.

Bit 7—Expanded Mode Enable (EXPE): Sets expanded mode. In mode 1, EXPE is fixed at 1 and cannot be modified. In modes 2 and 3, EXPE has an initial value of 0 and can be read or written.

Bit 7

| EXPE | Description |
|------|---------------------------|
| 0 | Single-chip mode selected |
| 1 | Expanded mode selected |

Bits 6 to 2—Reserved: These bits cannot be modified and are always read as 0.

Bits 1 and 0—Mode Select 1 and 0 (MDS1, MDS0): These bits indicate values that reflect the input levels of mode pins MD1 and MD0 (the current operating mode). Bits MDS1 and MDS0 correspond to pins MD1 and MD0, respectively. These are read-only bits, and cannot be modified. When MDCR is read, the input levels of mode pins MD1 and MD0 are latched in these bits.

22.3 Operation

The on-chip flash memory is connected to the CPU by a 16-bit data bus, and both byte and word data is accessed in one state. Even addresses are connected to the upper 8 bits, and odd addresses to the lower 8 bits. Word data must start at an even address.

The mode pins (MD1 and MD0) and the EXPE bit in MDCR can be set to enable or disable the on-chip ROM, as shown in table 22.2.

In normal mode, the maximum amount of ROM that can be used is 56 kbytes.

Table 22.2 Operating Modes and ROM

| Operating Mode | | | | | | |
|--------------------------|--------------------------|---|-----------|-----|------|-------------------------|
| MCU Operating Mode | CPU Operating Mode | Description | Mode Pins | | MDCR | |
| | | | MD1 | MD0 | EXPE | On-Chip ROM |
| Mode 1 | Normal | Expanded mode with on-chip ROM disabled | 0 | 1 | 1 | Disabled |
| Mode 2 | Advanced | Single-chip mode | 1 | 0 | 0 | Enabled (128 kbytes) |
| | Advanced | Expanded mode with on-chip ROM enabled | | | 1 | |
| Mode 3 | Normal | Single-chip mode | | 1 | 0 | Enabled (56 kbytes) |
| | Normal | Expanded mode with on-chip ROM enabled | | | 1 | |

22.4 Overview of Flash Memory

22.4.1 Features

The features of the flash memory are summarized below.

- Four flash memory operating modes
 - Program mode
 - Erase mode
 - Program-verify mode
 - Erase-verify mode
- Programming/erase methods

The flash memory is programmed 128 bytes at a time. Erasing is performed by block erase (in single-block units). When erasing multiple blocks, the individual blocks must be erased sequentially. Block erasing can be performed as required on 1-kbyte, 28-kbyte, 16-kbyte, 8-kbyte, and 32-kbyte blocks.
- Programming/erase times

The flash memory programming time is 10 ms (typ.) for simultaneous 128-byte programming, equivalent to approximately 80 μ s (typ.) per byte, and the erase time is 100 ms (typ.) per block.
- Reprogramming capability

The flash memory can be reprogrammed up to 100 times.
- On-board programming modes

There are two modes in which flash memory can be programmed/erased/verified on-board:

 - Boot mode
 - User program mode
- Automatic bit rate adjustment

With data transfer in boot mode, the bit rate of the chip can be automatically adjusted to match the transfer bit rate of the host.
- Protect modes

There are three protect modes, hardware, software, and error protect, which allow protected status to be designated for flash memory program/erase/verify operations.
- Programmer mode

Flash memory can be programmed/erased in programmer mode, using a PROM programmer, as well as in on-board programming mode.

22.4.2 Block Diagram

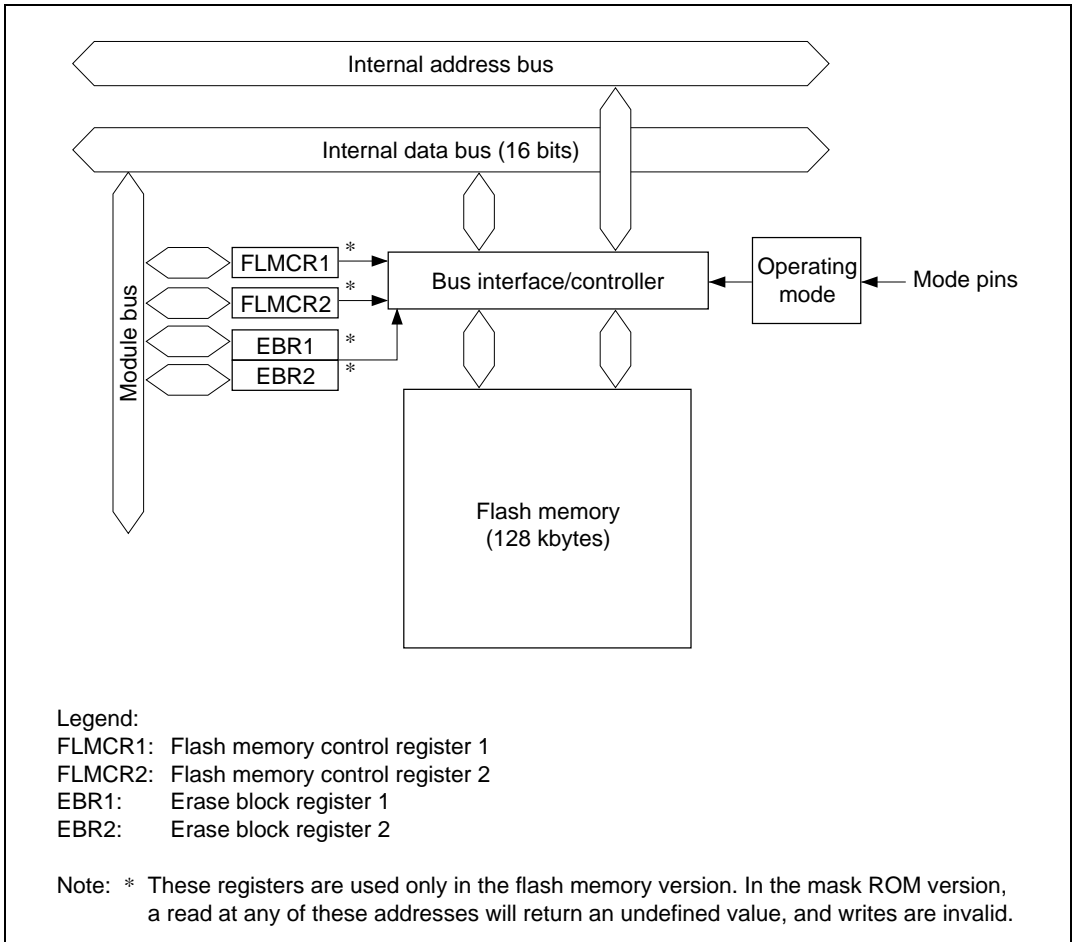


Figure 22.2 Block Diagram of Flash Memory

22.4.3 Flash Memory Operating Modes

Mode Transitions: When the mode pins are set in the reset state and a reset-start is executed, the MCU enters one of the operating modes shown in figure 22.3. In user mode, flash memory can be read but not programmed or erased.

Flash memory can be programmed and erased in boot mode, user program mode, and programmer mode.

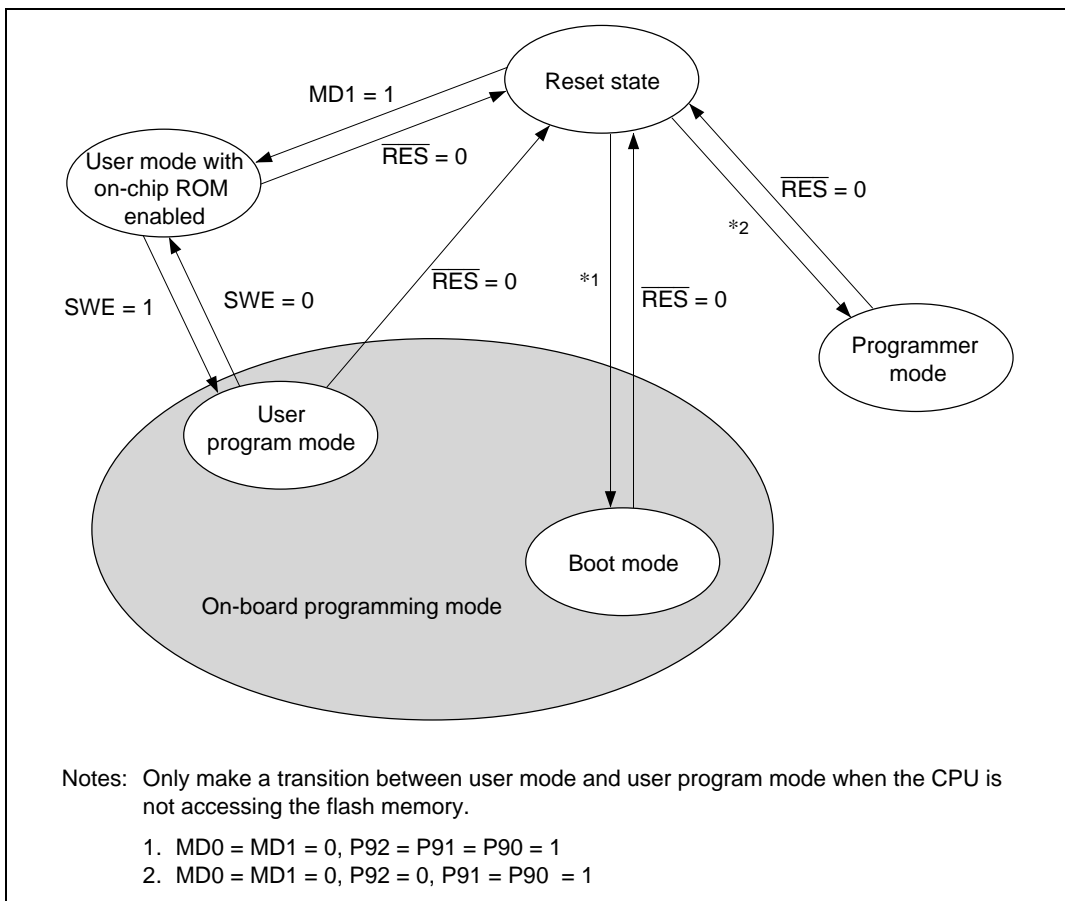


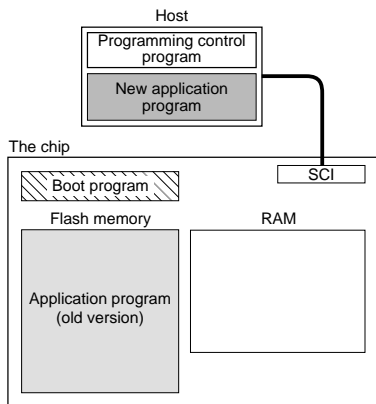
Figure 22.3 Flash Memory Mode Transitions

On-Board Programming Modes

- Boot mode

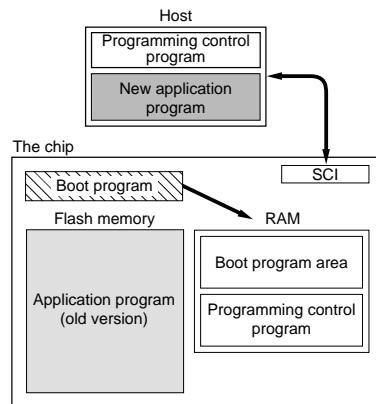
1. Initial state

The flash memory is in the erased state when the device is shipped. The description here applies to the case where the old program version or data is being rewritten. The user should prepare the programming control program and new application program beforehand in the host.



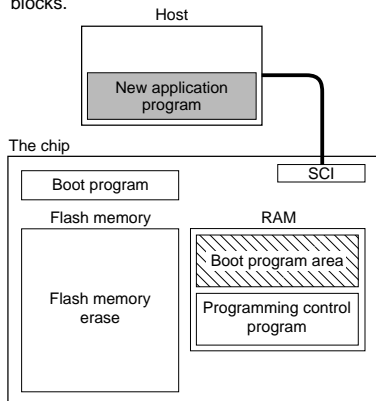
2. Programming control program transfer

When boot mode is entered, the boot program in the chip (originally incorporated in the chip) is started, an SCI communication check is carried out, and the boot program required for flash memory erasing is automatically transferred to the RAM boot program area.



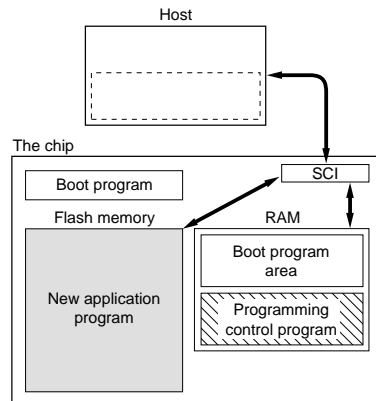
3. Flash memory initialization

The erase program in the boot program area (in RAM) is executed, and the flash memory is initialized (to H'FF). In boot mode, entire flash memory erasure is performed, without regard to blocks.



4. Writing new application program

The programming control program transferred from the host to RAM by SCI communication is executed, and the new application program in the host is written into the flash memory.




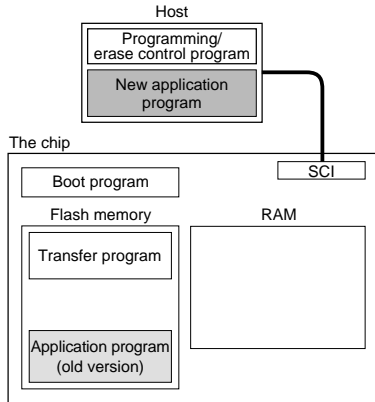
 Program execution state

Figure 22.4 Boot Mode

- User program mode

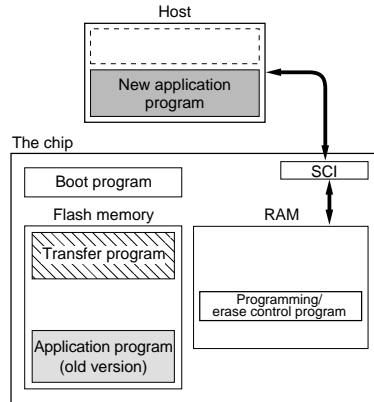
1. Initial state

(1) the program that will transfer the programming/ erase control program to on-chip RAM should be written into the flash memory by the user beforehand. (2) The programming/erase control program should be prepared in the host or in the flash memory.



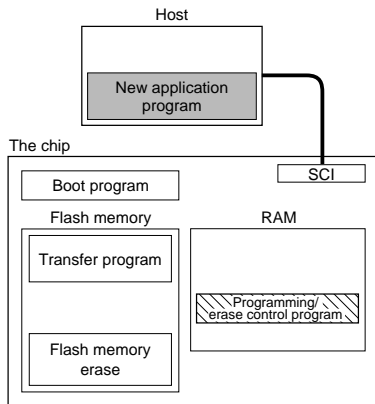
2. Programming/erase control program transfer

The transfer program in the flash memory is executed, and the programming/erase control program is transferred to RAM.



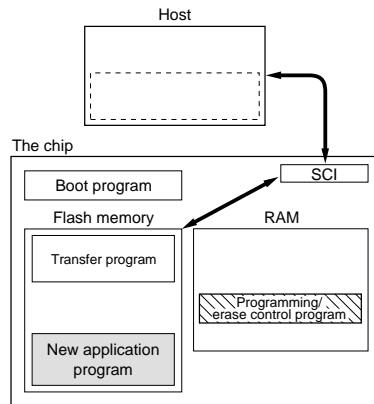
3. Flash memory initialization

The programming/erase program in RAM is executed, and the flash memory is initialized (to H'FF). Erasing can be performed in block units, but not in byte units.



4. Writing new application program

Next, the new application program in the host is written into the erased flash memory blocks. Do not write to unerased blocks.




 Program execution state

Figure 22.5 User Program Mode (Example)

Differences between Boot Mode and User Program Mode

| | Boot Mode | User Program Mode |
|------------------------------|------------------------|--|
| Entire memory erase | Yes | Yes |
| Block erase | No | Yes |
| Programming control program* | Program/program-verify | Erase/erase-verify Program/program-verify |

Note: * To be provided by the user, in accordance with the recommended algorithm.

Block Configuration: The flash memory is divided into two 32-kbyte blocks, two 8-kbyte blocks, one 16-kbyte block, one 28-kbyte block, and four 1-kbyte blocks.

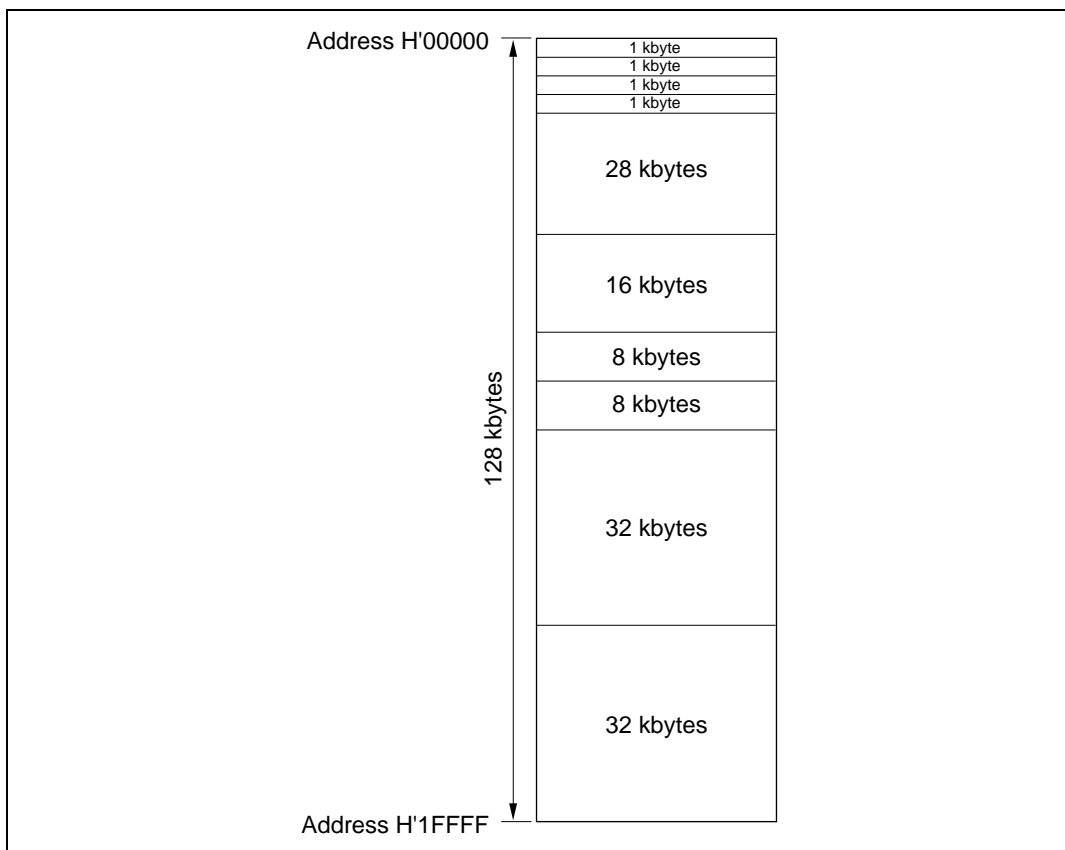


Figure 22.6 Flash Memory Block Configuration

22.4.4 Pin Configuration

The flash memory is controlled by means of the pins shown in table 22.3.

Table 22.3 Flash Memory Pins

| Pin Name | Abbreviation | I/O | Function |
|---------------|-------------------------|--------|--|
| Reset | $\overline{\text{RES}}$ | Input | Reset |
| Mode 1 | MD1 | Input | Sets MCU operating mode |
| Mode 0 | MD0 | Input | Sets MCU operating mode |
| Port 92 | P92 | Input | Sets MCU operating mode when MD1 = MD0 = 0 |
| Port 91 | P91 | Input | Sets MCU operating mode when MD1 = MD0 = 0 |
| Port 90 | P90 | Input | Sets MCU operating mode when MD1 = MD0 = 0 |
| Transmit data | TxD1 | Output | Serial transmit data output |
| Receive data | RxD1 | Input | Serial receive data input |

22.4.5 Register Configuration

The registers used to control the on-chip flash memory when enabled are shown in table 22.4. In order for these registers to be accessed, the FLSHE bit must be set to 1 in STCR.

Table 22.4 Flash Memory Registers

| Register Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|---------------------------------|----------------------|-------------------|--------------------|-----------------------|
| Flash memory control register 1 | FLMCR1 ^{*5} | R/W ^{*3} | H'80 | H'FF80 ^{*2} |
| Flash memory control register 2 | FLMCR2 ^{*5} | R/W ^{*3} | H'00 ^{*4} | H'FF81 ^{*2} |
| Erase block register 1 | EBR1 ^{*5} | R/W ^{*3} | H'00 ^{*4} | H'FF82 ^{*2} |
| Erase block register 2 | EBR2 ^{*5} | R/W ^{*3} | H'00 ^{*4} | H'FF83 ^{*2} |
| Serial timer control register | STCR | R/W | H'00 | H'FFC3 |

Notes: 1. Lower 16 bits of the address.

2. Flash memory registers share addresses with other registers. Register selection is performed by the FLSHE bit in the serial timer control register (STCR).
3. In modes in which the on-chip flash memory is disabled, a read will return H'00, and writes are invalid.
4. When the SWE bit in FLMCR1 is not set, these registers are initialized to H'00.
5. FLMCR1, FLMCR2, EBR1, and EBR2 are 8-bit registers. Only byte accesses are valid for these registers, the access requiring 2 states. These registers are used only in the flash memory version. In the mask ROM version, a read at any of these addresses will return an undefined value, and writes are invalid.

22.5 Register Descriptions

22.5.1 Flash Memory Control Register 1 (FLMCR1)

| | | | | | | | | |
|---------------|-----|-----|---|---|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | FWE | SWE | — | — | EV | PV | E | P |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R/W | — | — | R/W | R/W | R/W | R/W |

FLMCR1 is an 8-bit register used for flash memory operating mode control. Program-verify mode or erase-verify mode is entered by setting SWE to 1. Program mode is entered by setting SWE to 1, then setting the PSU bit in FLMCR2, and finally setting the P bit. Erase mode is entered by setting SWE to 1, then setting the ESU bit in FLMCR2, and finally setting the E bit. FLMCR1 is initialized to H'80 by a reset, and in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode. When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

Writes to the EV and PV bits in FLMCR1 are enabled only when SWE=1; writes to the E bit only when SWE = 1, and ESU = 1; and writes to the P bit only when SWE = 1, and PSU = 1.

Bit 7—Flash Write Enable (FWE): Sets hardware protection against flash memory programming/erasing. This bit cannot be modified and is always read as 1.

Bit 6—Software Write Enable (SWE): Enables or disables flash memory programming. SWE should be set before setting bits ESU, PSU, EV, PV, E, P, and EB7 to EB0, and should not be cleared at the same time as these bits.

Bit 6

| SWE | Description |
|-----|---------------------------------|
| 0 | Writes disabled (Initial value) |
| 1 | Writes enabled |

Bit 5 and 4—Reserved: These bits cannot be modified and are always read as 0.

Bit 3—Erase-Verify (EV): Selects erase-verify mode transition or clearing. Do not set the SWE, ESU, PSU, PV, E, or P bit at the same time.

Bit 3

| EV | Description |
|----|--|
| 0 | Erase-verify mode cleared (Initial value) |
| 1 | Transition to erase-verify mode [Setting condition] When SWE = 1 |

Bit 2—Program-Verify (PV): Selects program-verify mode transition or clearing. Do not set the SWE, ESU, PSU, EV, E, or P bit at the same time.

Bit 2

| PV | Description |
|----|--|
| 0 | Program-verify mode cleared (Initial value) |
| 1 | Transition to program-verify mode [Setting condition] When SWE = 1 |

Bit 1—Erase (E): Selects erase mode transition or clearing. Do not set the SWE, ESU, PSU, EV, PV, or P bit at the same time.

Bit 1

| E | Description |
|---|--|
| 0 | Erase mode cleared (Initial value) |
| 1 | Transition to erase mode [Setting condition] When SWE = 1, and ESU = 1 |

Bit 0—Program (P): Selects program mode transition or clearing. Do not set the SWE, PSU, ESU, EV, PV, or E bit at the same time.

Bit 0

| P | Description |
|---|--|
| 0 | Program mode cleared (Initial value) |
| 1 | Transition to program mode [Setting condition] When SWE = 1, and PSU = 1 |

22.5.2 Flash Memory Control Register 2 (FLMCR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|-----|-----|
| | FLER | — | — | — | — | — | ESU | PSU |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | — | — | — | — | — | R/W | R/W |

FLMCR2 is an 8-bit register that monitors the presence or absence of flash memory program/erase protection (error protection) and performs setup for flash memory program/erase mode. FLMCR2 is initialized to H'00 by a reset, and in hardware standby mode. The ESU and PSU bits are cleared to 0 in software standby mode, subactive mode, subsleep mode, and watch mode.

When on-chip flash memory is disabled, a read will return H'00 and writes are invalid.

Bit 7—Flash Memory Error (FLER): Indicates that an error has occurred during an operation on flash memory (programming or erasing). When FLER is set to 1, flash memory goes to the error-protection state.

Bit 7

| FLER | Description |
|------|---|
| 0 | Flash memory is operating normally (Initial value) Flash memory program/erase protection (error protection) is disabled [Clearing condition] Reset or hardware standby mode |
| 1 | An error has occurred during flash memory programming/erasing Flash memory program/erase protection (error protection) is enabled [Setting condition] See section 22.8.3, Error Protection |

Bits 6 to 2—Reserved: Should always be written with 0.

Bit 1—Erase Setup (ESU): Prepares for a transition to erase mode. Set this bit to 1 before setting the E bit to 1 in FLMCR1. Do not set the SWE, PSU, EV, PV, E, or P bit at the same time.

Bit 1

| ESU | Description |
|-----|--|
| 0 | Erase setup cleared (Initial value) |
| 1 | Erase setup [Setting condition] When SWE = 1 |

Bit 0—Program Setup (PSU): Prepares for a transition to program mode. Set this bit to 1 before setting the P bit to 1 in FLMCR1. Do not set the SWE, ESU, EV, PV, E, or P bit at the same time.

Bit 0

| PSU | Description |
|-----|--|
| 0 | Program setup cleared (Initial value) |
| 1 | Program setup [Setting condition] When SWE = 1 |

22.5.3 Erase Block Registers 1 and 2 (EBR1, EBR2)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-------|-------|
| EBR1 | — | — | — | — | — | — | EB9 | EB8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | —*2 | —*2 | —*2 | —*2 | —*2 | —*2 | R/W*1 | R/W*1 |

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-----|-----|-----|-----|-----|-----|-----|
| EBR2 | EB7 | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W*1 | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

- Notes: 1. In normal mode, these bits cannot be modified and are always read as 0.
 2. This bit must not be set to 1.

EBR1 and EBR2 are registers that specify the flash memory erase area block by block; bits 1 and 0 in EBR1 and bits 7 to 0 in EBR2 are readable/writable bits. EBR1 and EBR2 are each initialized to H'00 by a reset, in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode, and when the SWE bit in FLMCR1 is not set. When a bit in EBR1 and EBR2 is set, the corresponding block can be erased. Other blocks are erase-protected. Set only one bit in EBR1 and EBR2 (more than one bit cannot be set). When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

The flash memory block configuration is shown in table 22.5.

Table 22.5 Flash Memory Erase Blocks

| Block (Size) | Address |
|-----------------|--------------------------|
| EB0 (1 kbyte) | H'(00)0000 to H'(00)03FF |
| EB1 (1 kbyte) | H'(00)0400 to H'(00)07FF |
| EB2 (1 kbyte) | H'(00)0800 to H'(00)0BFF |
| EB3 (1 kbytes) | H'(00)0C00 to H'(00)0FFF |
| EB4 (28 kbytes) | H'(00)1000 to H'(00)7FFF |
| EB5 (16 kbytes) | H'(00)8000 to H'(00)BFFF |
| EB6 (8 kbytes) | H'(00)C000 to H'(00)DFFF |
| EB7 (8 kbytes) | H'00E000 to H'00FFFF |
| EB8 (32 kbytes) | H'010000 to H'017FFF |
| EB9 (32 kbytes) | H'018000 to H'01FFFF |

22.5.4 Serial Timer Control Register (STCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-------|-------|------|-------|-----|-------|-------|
| | — | IICX1 | IICX0 | IICE | FLSHE | — | ICKS1 | ICKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), and on-chip flash memory, and also selects the TCNT input clock. For details on functions not related to on-chip flash memory, see section 3.2.4, Serial Timer Control Register (STCR), and descriptions of individual modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7—Reserved: Do not set to 1.

Bits 6 to 4—I²C Control (IICX1, IICX0, IICE): These bits control the operation of the I²C bus interface. For details, see section 16, I²C Bus Interface [H8S/2138 Group Option].

Bit 3—Flash Memory Control Register Enable (FLSHE): Setting the FLSHE bit to 1 enables read/write access to the flash memory control registers. If FLSHE is cleared to 0, the flash memory control registers are deselected. In this case, the flash memory control register contents are retained.

Bit 3

| FLSHE | Description |
|-------|---|
| 0 | Flash memory control registers deselected (Initial value) |
| 1 | Flash memory control registers selected |

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits control 8-bit timer operation. See section 12, 8-Bit Timers, for details.

22.6 On-Board Programming Modes

When pins are set to on-board programming mode, program/erase/verify operations can be performed on the on-chip flash memory. There are two on-board programming modes: boot mode and user program mode. The pin settings for transition to each of these modes are shown in table 22.6. For a diagram of the transitions to the various flash memory modes, see figure 22.3.

Only advanced mode setting is possible for boot mode.

In the case of user program mode, established in advanced mode or normal mode, depending on the setting of the MD0 pin. In normal mode, only programming of a 56-kbyte area of flash memory is possible.

Table 22.6 Setting On-Board Programming Modes

| Mode Name | Mode | | | | | |
|-------------------|--------------------|-----|-----|-----|-----|-----|
| | CPU Operating Mode | MD1 | MD0 | P92 | P91 | P90 |
| Boot mode | Advanced mode | 0 | 0 | 1* | 1* | 1* |
| User program mode | Advanced mode | 1 | 0 | — | — | — |
| | Normal mode | | 1 | — | — | — |

Note: * Can be used as I/O ports after boot mode is initiated.

22.6.1 Boot Mode

When boot mode is used, the flash memory programming control program must be prepared in the host beforehand. The channel 1 SCI to be used is set to asynchronous mode.

When a reset-start is executed after the chip's pins have been set to boot mode, the boot program built into the chip is started and the programming control program prepared in the host is serially transmitted to the chip via the SCI. In the chip, the programming control program received via the SCI is written into the programming control program area in on-chip RAM. After the transfer is completed, control branches to the start address of the programming control program area and the programming control program execution state is entered (flash memory programming is performed).

The transferred programming control program must therefore include coding that follows the programming algorithm given later.

The system configuration in boot mode is shown in figure 22.7, and the boot program mode execution procedure in figure 22.8.

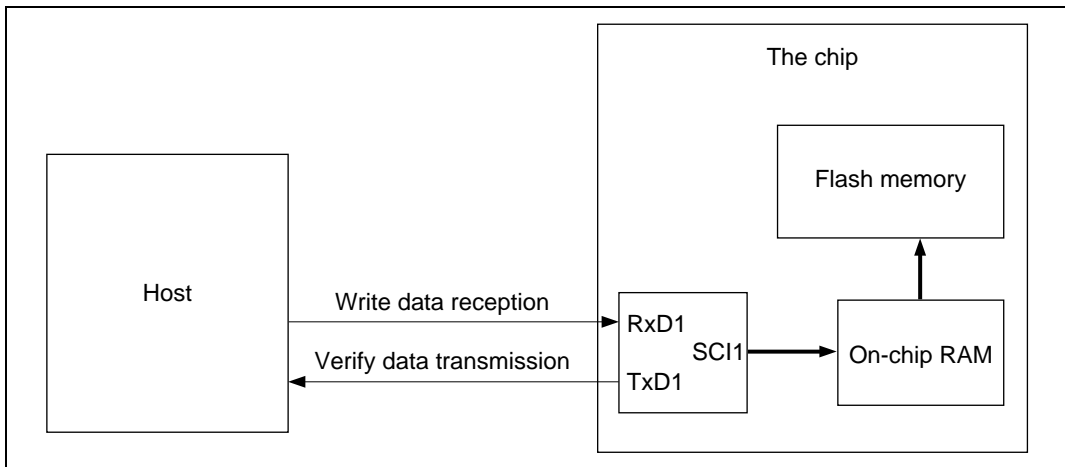


Figure 22.7 System Configuration in Boot Mode

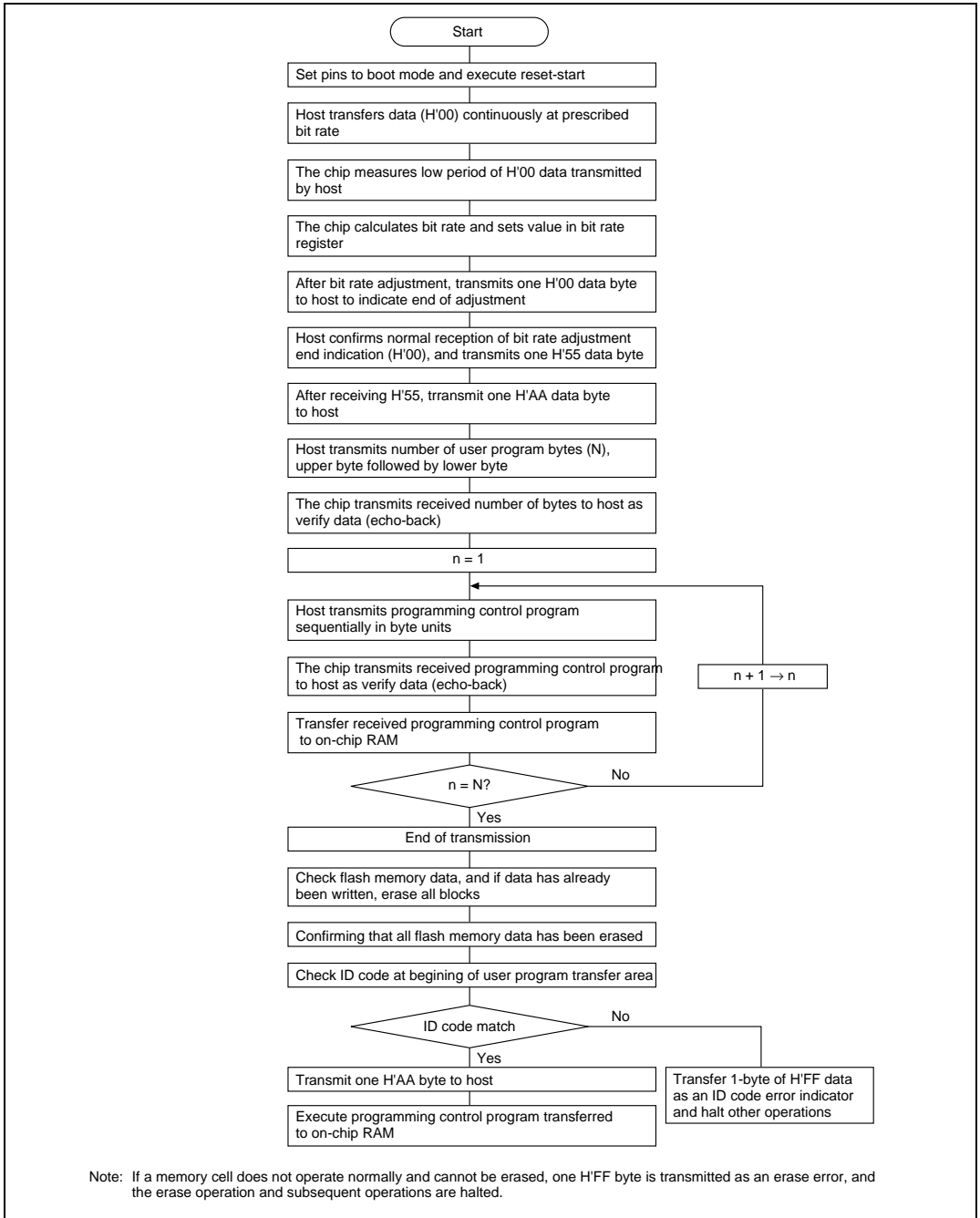


Figure 22.8 Boot Mode Execution Procedure

Automatic SCI Bit Rate Adjustment

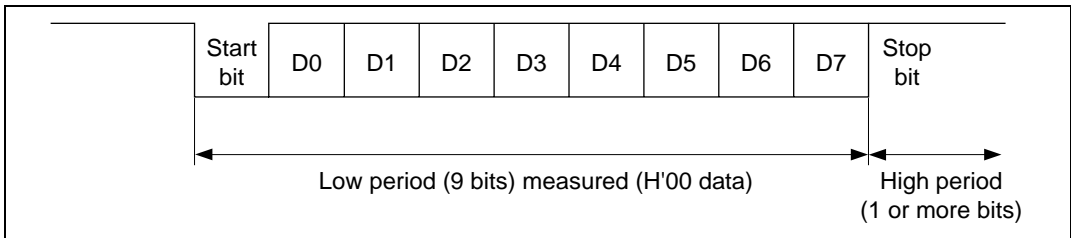


Figure 22.9 Automatic SCI Bit Rate Adjustment

When boot mode is initiated, the chip measures the low period of the asynchronous SCI communication data (H'00) transmitted continuously from the host. The SCI transmit/receive format should be set as follows: 8-bit data, 1 stop bit, no parity. The chip calculates the bit rate of the transmission from the host from the measured low period, and transmits one H'00 byte to the host to indicate the end of bit rate adjustment. The host should confirm that this adjustment end indication (H'00) has been received normally, and transmit one H'55 byte to the chip. If reception cannot be performed normally, initiate boot mode again (reset), and repeat the above operations. Depending on the host's transmission bit rate and the chip's system clock frequency, there will be a discrepancy between the bit rates of the host and the chip. To ensure correct SCI operation, the host's transfer bit rate should be set to (4800, 9600, or 19200) bps.

Table 22.7 shows typical host transfer bit rates and system clock frequencies for which automatic adjustment of the chip's bit rate is possible. The boot program should be executed within this system clock range.

Table 22.7 System Clock Frequencies for which Automatic Adjustment of the Chip's Bit Rate Is Possible

| Host Bit Rate | System Clock Frequency for which Automatic Adjustment of Bit Rate Is Possible |
|---------------|---|
| 19200 bps | 8 MHz to 20 MHz |
| 9600 bps | 4 MHz to 20 MHz |
| 4800 bps | 2 MHz to 18 MHz |

On-Chip RAM Area Divisions in Boot Mode: In boot mode, the 1920-byte area from H'(FF)E880 to H'(FF) EFFF and the 128-byte area from H'(FF)FF00 to H'(FF)FF7F is reserved for use by the boot program, as shown in figure 22.10. The area to which the programming control program is transferred is H'(FF)E080 to H'(FF)E87F (2048 bytes). However, the 8-byte area from H'(FF)E080 to H'(FF)E087 is reserved for ID codes as shown in figure 22.10. The boot program

area can be used when the programming control program transferred into the RAM enters the execution state. A stack area should be set up as required.

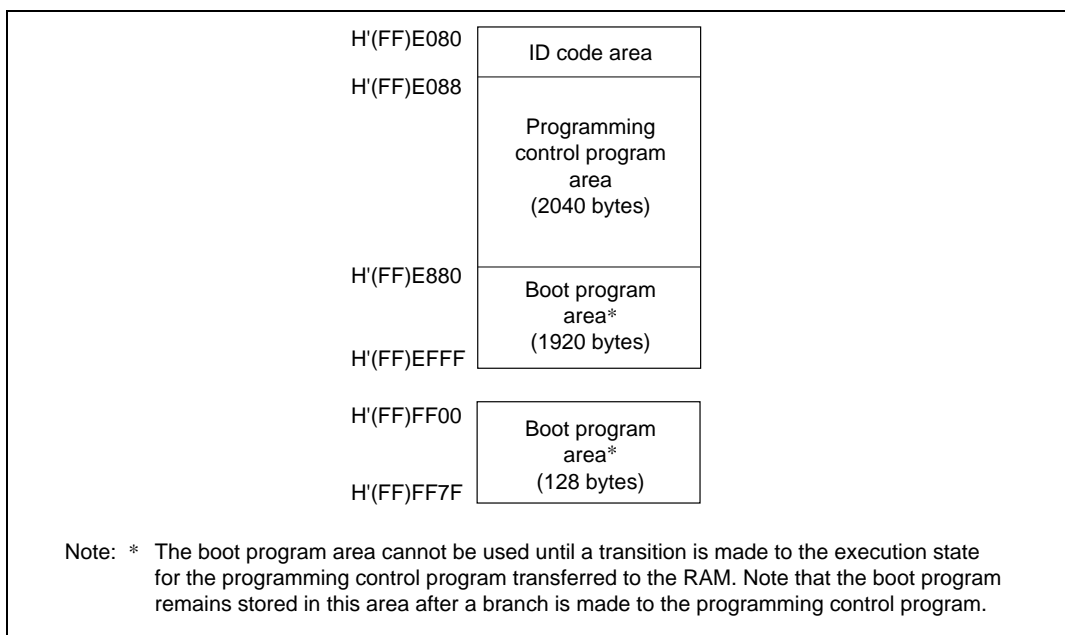
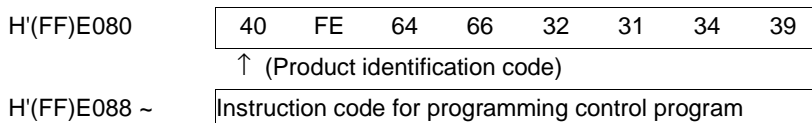


Figure 22.10 RAM Areas in Boot Mode

In the boot mode of this chip, the content in the 8-byte ID code area shown below is confirmed so that whether or not there is a programming control program that corresponds to the chip can be checked.



When a new programming-control program for use in boot mode is created, add the 8-byte ID code described above to the head of the program.

Notes on Use of Boot Mode:

- When the chip comes out of reset in boot mode, it measures the low period of the input at the SCI's RxD1 pin. The reset should end with RxD1 high. After the reset ends, it takes about 100 states for the chip to get ready to measure the low period of the RxD1 input.

- In boot mode, if any data has been programmed into the flash memory (if all data is not 1), all flash memory blocks are erased. Boot mode is for use when user program mode is unavailable, such as the first time on-board programming is performed, or if the program activated in user program mode is accidentally erased.
- Interrupts cannot be used while the flash memory is being programmed or erased.
- The Rx/D1 and Tx/D1 pins should be pulled up on the board.
- Before branching to the programming control program (RAM area H'(FF)E080), the chip terminates transmit and receive operations by the on-chip SCI (channel 1) (by clearing the RE and TE bits in SCR to 0), but the adjusted bit rate value remains set in BRR. The transmit data output pin, Tx/D1, goes to the high-level output state (P84DDR = 1, P84DR = 1).

The contents of the CPU's internal general registers are undefined at this time, so these registers must be initialized immediately after branching to the programming control program. In particular, since the stack pointer (SP) is used implicitly in subroutine calls, etc., a stack area must be specified for use by the programming control program.

The initial values of other on-chip registers are not changed.

- Boot mode can be entered by making the pin settings shown in table 22.6 and executing a reset-start.

When the chip detects the boot mode setting at reset release^{*1}, P92, P91, and P90 can be used as I/O ports.

Boot mode can be cleared by driving the reset pin low, waiting at least 20 states, then setting the mode pins, and executing reset release^{*1}. Boot mode can also be cleared by a WDT overflow reset. The mode pin input levels must not be changed in boot mode.

- If the mode pin input levels are changed (for example, from low to high) during a reset, the state of ports with multiplexed address functions and bus control output pins (\overline{AS} , \overline{RD} , \overline{HWR}) will change according to the change in the microcomputer's operating mode^{*2}.

Therefore, care must be taken to make pin settings to prevent these pins from becoming output signal pins during a reset, or to prevent collision with signals outside the microcomputer.

- Notes:
1. Mode pins input must satisfy the mode programming setup time ($t_{MDS} = 4$ states) with respect to the reset release timing.
 2. Ports with multiplexed address functions will output a low level as the address signal if mode pin setting is for mode 1 is entered during a reset. In other modes, the port pins go to the high-impedance state. The bus control output signals will output a high level if mode pin setting is for mode 1 is entered during a reset. In other modes, the port pins go to the high-impedance state.

22.6.2 User Program Mode

When set to user program mode, the chip can program and erase its flash memory by executing a user program/erase control program. Therefore, on-board reprogramming of the on-chip flash memory can be carried out by providing an on-board means of supplying programming data, and storing a program/erase control program in part of the program area as necessary.

To select user program mode, select a mode that enables the on-chip flash memory (mode 2 or 3). In this mode, on-chip supporting modules other than flash memory operate as they normally would in mode 2 and 3.

The flash memory itself cannot be read while the SWE bit is set to 1 to perform programming or erasing, so the control program that performs programming and erasing should be run in on-chip RAM or external memory.

Figure 22.11 shows the procedure for executing the program/erase control program when transferred to on-chip RAM.

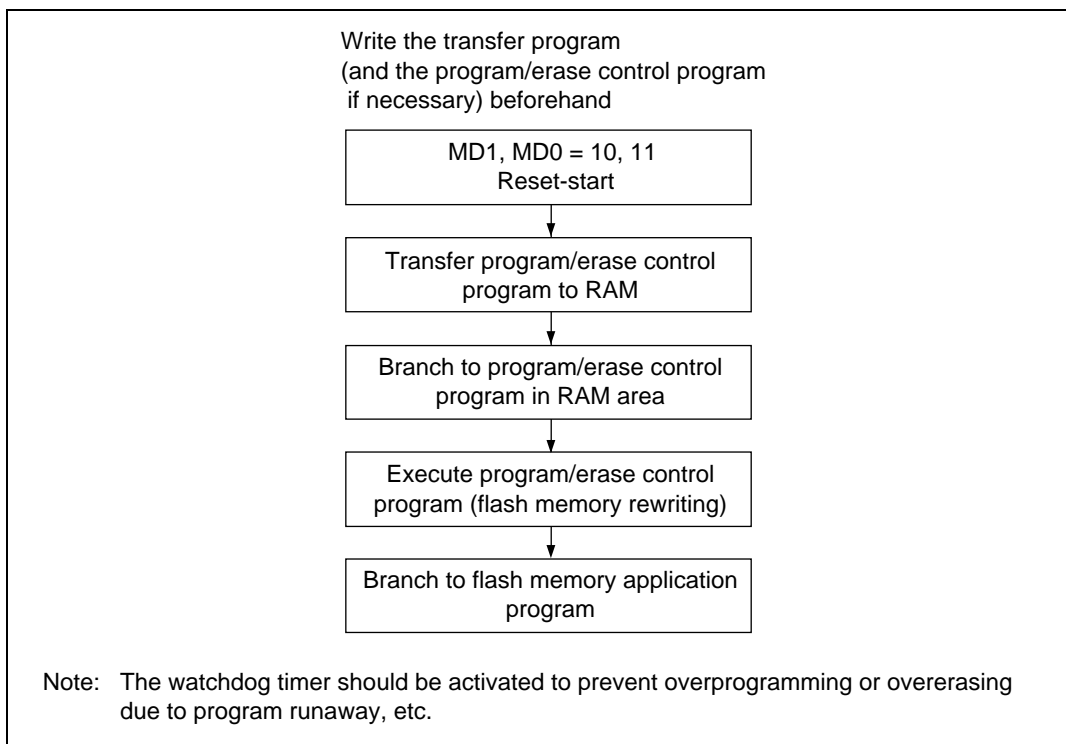


Figure 22.11 User Program Mode Execution Procedure

22.7 Programming/Erasing Flash Memory

In the on-board programming modes, flash memory programming and erasing is performed by software, using the CPU. There are four flash memory operating modes: program mode, erase mode, program-verify mode, and erase-verify mode. Transitions to these modes can be made by setting the PSU and ESU bits in FLMCR2, and the P, E, PV, and EV bits in FLMCR1.

The flash memory cannot be read while being programmed or erased. Therefore, the program that controls flash memory programming/erasing (the programming control program) should be located and executed in on-chip RAM or external memory.

- Notes:
1. Operation is not guaranteed if setting/resetting of the SWE, EV, PV, E, and P bits in FLMCR1, and the ESU and PSU bits in FLMCR2, is executed by a program in flash memory.
 2. Perform programming in the erased state. Do not perform additional programming on previously programmed addresses.

22.7.1 Program Mode

Follow the procedure shown in the program/program-verify flowchart in figure 22.12 to write data or programs to flash memory. Performing program operations according to this flowchart will enable data or programs to be written to flash memory without subjecting the device to voltage stress or sacrificing program data reliability. Programming should be carried out 128 bytes at a time.

The wait times (x , y , $z1$, $z2$, $z3$, α , β , γ , ϵ , η , θ) after setting/clearing individual bits in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the maximum number of writes (N) are shown in section 25, Electrical Characteristics, Flash Memory Characteristics.

Following the elapse of (x) μ s or more after the SWE bit is set to 1 in flash memory control register 1 (FLMCR1), 128-byte program data is stored in the program data area and reprogram data area, and the 128-byte data in the reprogram data area written consecutively to the write addresses. The lower 8 bits of the first address written to must be H'00 or H'80. 128 consecutive byte data transfers are performed. The program address and program data are latched in the flash memory. A 128-byte data transfer must be performed even if writing fewer than 128 bytes; in this case, H'FF data must be written to the extra addresses.

Next, the watchdog timer is set to prevent overprogramming in the event of program runaway, etc. Set a value greater than ($y + z2 + \alpha + \beta$) μ s as the WDT overflow period. After this, preparation for program mode (program setup) is carried out by setting the PSU bit in FLMCR2, and after the elapse of (y) μ s or more, the operating mode is switched to program mode by setting the P bit in

FLMCR1. The time during which the P bit is set is the flash memory programming time. Make a program setting so that the time for one programming operation is within the range of (z1), (z2) or (z3) μ s.

22.7.2 Program-Verify Mode

In program-verify mode, the data written in program mode is read to check whether it has been correctly written in the flash memory.

After the elapse of a given programming time, the programming mode is exited (the P bit in FLMCR1 is cleared, then the PSU bit in FLMCR2 is cleared at least (α) μ s later). The watchdog timer is cleared after the elapse of (β) μ s or more, and the operating mode is switched to program-verify mode by setting the PV bit in FLMCR1. Before reading in program-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) μ s or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) μ s after the dummy write before performing this read operation. Next, the originally written data is compared with the verify data, and reprogram data is computed (see figure 22.12) and transferred to the reprogram data area. After 128 bytes of data have been verified, exit program-verify mode, wait for at least (η) μ s. If the programming count is less than 6, the 128-byte data in the additional program data area should be written consecutively to the write addresses, and additional programming performed. Next clear the SWE bit in FLMCR1, and wait at least (θ) μ s. If reprogramming is necessary, set program mode again, and repeat the program/program-verify sequence as before. However, ensure that the program/program-verify sequence is not repeated more than (N) times on the same bits.

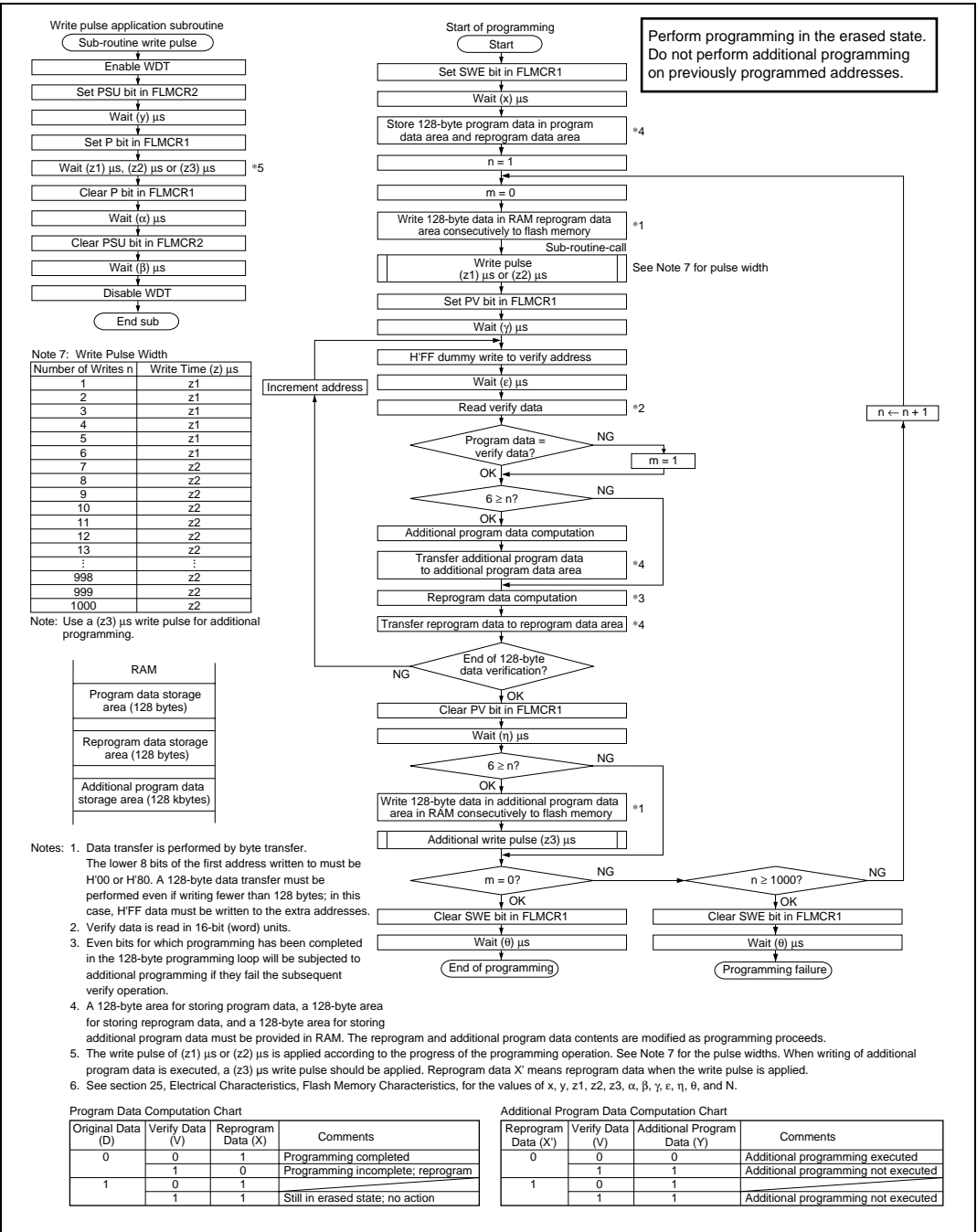


Figure 22.12 Program/Program-Verify Flowchart

22.7.3 Erase Mode

Flash memory erasing should be performed block by block following the procedure shown in the erase/erase-verify flowchart (single-block erase) shown in figure 22.13.

The wait times (x , y , z , α , β , γ , ϵ , η , θ) after setting/clearing individual bits in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the maximum number of erase (N) are shown in section 25, Electrical Characteristics, Flash Memory Characteristics.

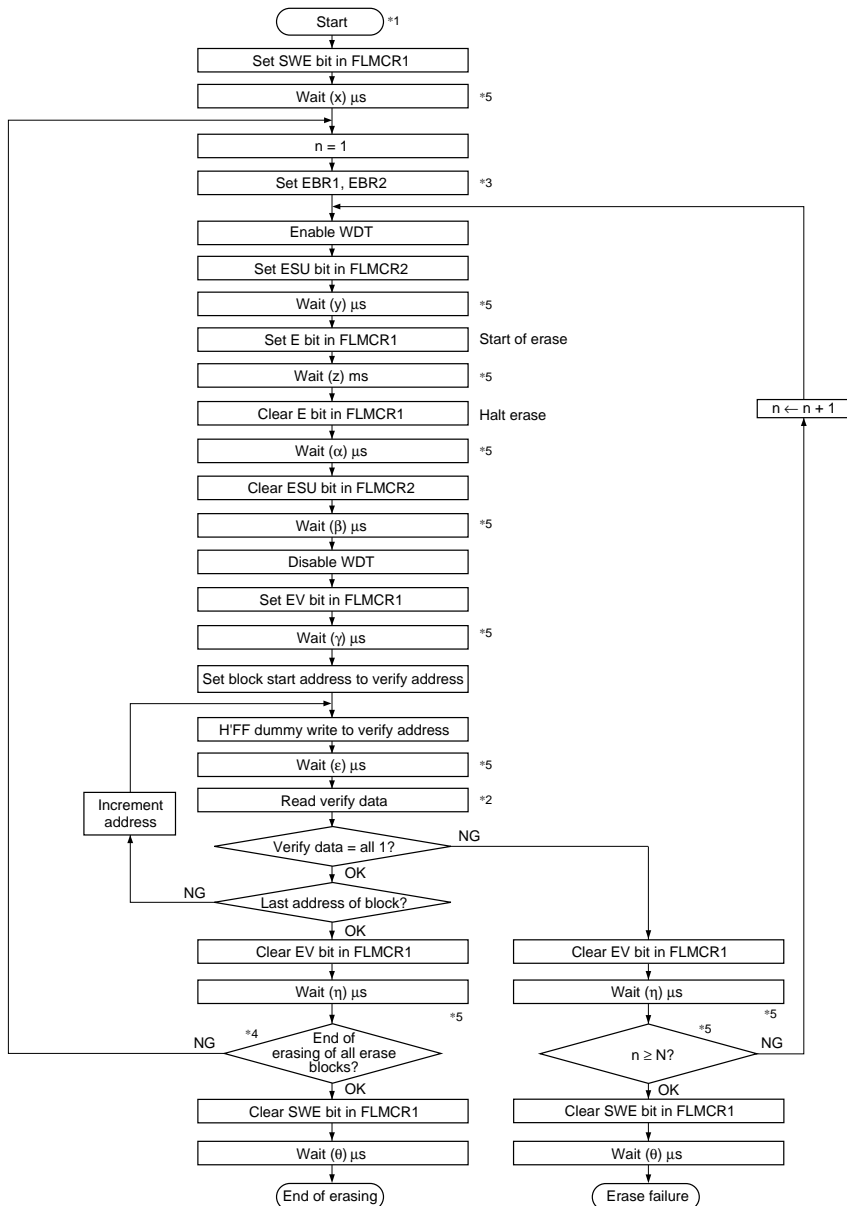
To perform data or program erasure, make a 1 bit setting for the flash memory area to be erased in erase block register 1 or 2 (EBR1 or EBR2) at least (x) μ s after setting the SWE bit to 1 in flash memory control register 1 (FLMCR1). Next, the watchdog timer is set to prevent overerasing in the event of program runaway, etc. Set a value greater than ($y + z + \alpha + \beta$) ms as the WDT overflow period. After this, preparation for erase mode (erase setup) is carried out by setting the ESU bit in FLMCR2, and after the elapse of (y) μ s or more, the operating mode is switched to erase mode by setting the E bit in FLMCR1. The time during which the E bit is set is the flash memory erase time. Ensure that the erase time does not exceed (z) ms.

Note: With flash memory erasing, preprogramming (setting all data in the memory to be erased to 0) is not necessary before starting the erase procedure.

22.7.4 Erase-Verify Mode

In erase-verify mode, data is read after memory has been erased to check whether it has been correctly erased.

After the elapse of the erase time, erase mode is exited (the E bit in FLMCR1 is cleared, then the ESU bit in FLMCR2 is cleared at least (α) μ s later), the watchdog timer is cleared after the elapse of (β) μ s or more, and the operating mode is switched to erase-verify mode by setting the EV bit in FLMCR1. Before reading in erase-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) μ s or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) μ s after the dummy write before performing this read operation. If the read data has been erased (all 1), a dummy write is performed to the next address, and erase-verify is performed. If the read data has not been erased, set erase mode again, and repeat the erase/erase-verify sequence in the same way. However, ensure that the erase/erase-verify sequence is not repeated more than (N) times. When verification is completed, exit erase-verify mode, and wait for at least (η) μ s. If erasure has been completed on all the erase blocks, clear the SWE bit in FLMCR1, and wait (θ) μ s. If there are any unerased blocks, make a 1 bit setting in EBR1 or EBR2 for the flash memory area to be erased, and repeat the erase/erase-verify sequence in the same way.



- Notes:
1. Preprogramming (setting erase block data to all 0) is not necessary.
 2. Verify data is read in 16-bit (W) units.
 3. Set only one bit in EBR1 or EBR2. More than one bit cannot be set.
 4. Erasing is performed in block units. To erase a number of blocks, the individual blocks must be erased sequentially.
 5. See section 25, Electrical Characteristics, Flash Memory Characteristics, for the values of x, y, z, α, β, γ, ε, η, θ, and N.

Figure 22.13 Erase/Erase-Verify Flowchart (Single-Block Erase)

22.8 Flash Memory Protection

There are three kinds of flash memory program/erase protection: hardware protection, software protection, and error protection.

22.8.1 Hardware Protection

Hardware protection refers to a state in which programming/erasing of flash memory is forcibly disabled or aborted. Hardware protection is reset by settings in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and erase block registers 1 and 2 (EBR1, EBR2). (See table 22.8.)

Table 22.8 Hardware Protection

| Item | Description | Functions | |
|--------------------------|---|-----------|-------|
| | | Program | Erase |
| Reset/standby protection | <ul style="list-style-type: none"> In a reset (including a WDT overflow reset) and in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode, FLMCR1, FLMCR2, EBR1, and EBR2 are initialized, and the program/erase-protected state is entered. In a reset via the $\overline{\text{RES}}$ pin, the reset state is not entered unless the $\overline{\text{RES}}$ pin is held low until oscillation stabilizes after powering on. In the case of a reset during operation, hold the $\overline{\text{RES}}$ pin low for the $\overline{\text{RES}}$ pulse width specified in the AC Characteristics section. | Yes | Yes |

22.8.2 Software Protection

Software protection can be implemented by setting the SWE bit in FLMCR1 and erase block registers 1 and 2 (EBR1, EBR2). When software protection is in effect, setting the P or E bit in flash memory control register 1 (FLMCR1) does not cause a transition to program mode or erase mode. (See table 22.9.)

Table 22.9 Software Protection

| Item | Description | Functions | |
|--------------------------------|---|-----------|-------|
| | | Program | Erase |
| SWE bit protection | <ul style="list-style-type: none"> Clearing the SWE bit to 0 in FLMCR1 sets the program/erase-protected state for all blocks. (Execute in on-chip RAM or external memory.) | Yes | Yes |
| Block specification protection | <ul style="list-style-type: none"> Erase protection can be set for individual blocks by settings in erase block registers 1 and 2 (EBR1, EBR2). Setting EBR1 and EBR2 to H'00 places all blocks in the erase-protected state. | — | Yes |

22.8.3 Error Protection

In error protection, an error is detected when MCU runaway occurs during flash memory programming/erasing, or operation is not performed in accordance with the program/erase algorithm, and the program/erase operation is aborted. Aborting the program/erase operation prevents damage to the flash memory due to overprogramming or overerasing.

If the MCU malfunctions during flash memory programming/erasing, the FLER bit is set to 1 in FLMCR2 and the error protection state is entered. The FLMCR1, FLMCR2, EBR1, and EBR2 settings are retained, but program mode or erase mode is aborted at the point at which the error occurred. Program mode or erase mode cannot be re-entered by re-setting the P or E bit. However, PV and EV bit setting is enabled, and a transition can be made to verify mode.

FLER bit setting conditions are as follows:

- When flash memory is read during programming/erasing (including a vector read or instruction fetch)
- Immediately after exception handling (excluding a reset) during programming/erasing
- When a SLEEP instruction (including software standby, sleep, subactive, subsleep and watch mode) is executed during programming/erasing
- When the bus is released during programming/erasing

Error protection is released only by a reset and in hardware standby mode.

Figure 22.14 shows the flash memory state transition diagram.

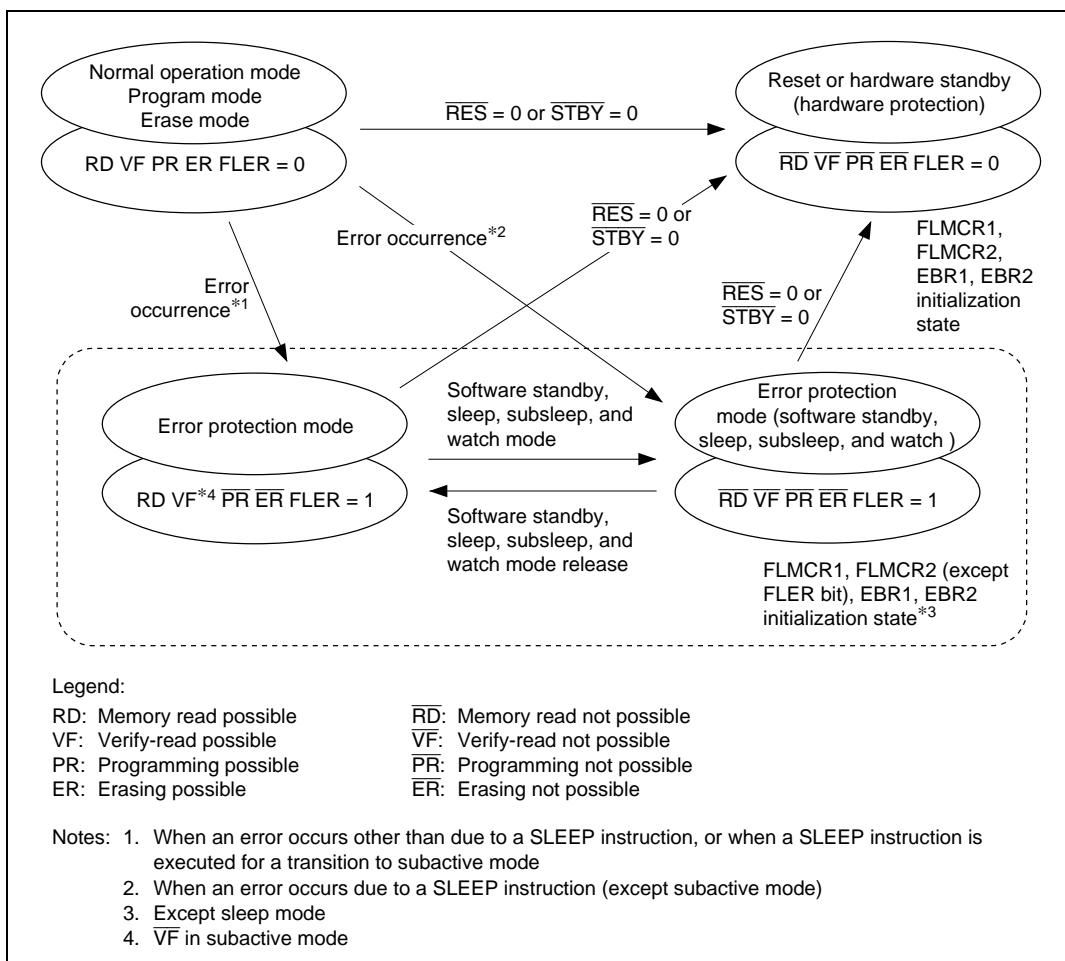


Figure 22.14 Flash Memory State Transitions

22.9 Interrupt Handling when Programming/Erasing Flash Memory

All interrupts, including NMI input is disabled when flash memory is being programmed or erased (when the P or E bit is set in FLMCR1), and while the boot program is executing in boot mode^{*1}, to give priority to the program or erase operation. There are three reasons for this:

1. Interrupt during programming or erasing might cause a violation of the programming or erasing algorithm, with the result that normal operation could not be assured.
2. In the interrupt exception handling sequence during programming or erasing, the vector would not be read correctly^{*2}, possibly resulting in MCU runaway.
3. If interrupt occurred during boot program execution, it would not be possible to execute the normal boot mode sequence.

For these reasons, in on-board programming mode alone there are conditions for disabling interrupt, as an exception to the general rule. However, this provision does not guarantee normal erasing and programming or MCU operation. All interrupt requests, including NMI input, must therefore be disabled inside and outside the MCU when programming or erasing flash memory. Interrupt is also disabled in the error-protection state while the P or E bit remains set in FLMCR1.

- Notes:
1. Interrupt requests must be disabled inside and outside the MCU until the programming control program has completed programming.
 2. The vector may not be read correctly in this case for the following two reasons:
 - If flash memory is read while being programmed or erased (while the P or E bit is set in FLMCR1), correct read data will not be obtained (undetermined values will be returned).
 - If the interrupt entry in the vector table has not been programmed yet, interrupt exception handling will not be executed correctly.

22.10 Flash Memory Programmer Mode

22.10.1 Programmer Mode Setting

Programs and data can be written and erased in programmer mode as well as in the on-board programming modes. In programmer mode, the on-chip ROM can be freely programmed using a PROM programmer that supports Renesas Technology microcomputer device types with 128-kbyte on-chip flash memory*. For precautions concerning the use of programmer mode, see section 22.10.10, Notes on Memory Programming and section 22.11, Flash Memory Programming and Erasing Precautions. Flash memory read mode, auto-program mode, auto-erase mode, and status read mode are supported with these device types. In auto-program mode, auto-erase mode, and status read mode, a status polling procedure is used, and in status read mode, detailed internal signals are output after execution of an auto-program or auto-erase operation.

Table 22.10 shows programmer mode pin settings.

Note: * Use products of the H8S/2138 A-mask version (in either 5-V or 3-V version) with the writing voltage for PROM programmer set to 3.3 V. Do not use products other than the A-mask version with 3.3-V PROM programmer setting.

Table 22.10 Programmer Mode Pin Settings

| Pin Names | Setting/External Circuit Connection |
|---|--|
| Mode pins: MD1, MD0 | Low-level input to MD1, MD0 |
| STBY pin | High-level input (Hardware standby mode not set) |
| RES pin | Power-on reset circuit |
| XTAL and EXTAL pins | Oscillation circuit |
| Other setting pins: P97, P92, P91, P90, P67 | Low-level input to p92, p67, high-level input to P97, P91, P90 |

22.10.2 Socket Adapters and Memory Map

In programmer mode, a socket adapter is mounted on the writer programmer to match the package concerned. Socket adapters are available for each writer manufacturer supporting Renesas Technology microcomputer device types with 128-kbyte on-chip flash memory.

Figure 22.15 shows the memory map in programmer mode. For pin names in programmer mode, see section 1.3.2, Pin Functions in Each Operating Mode.

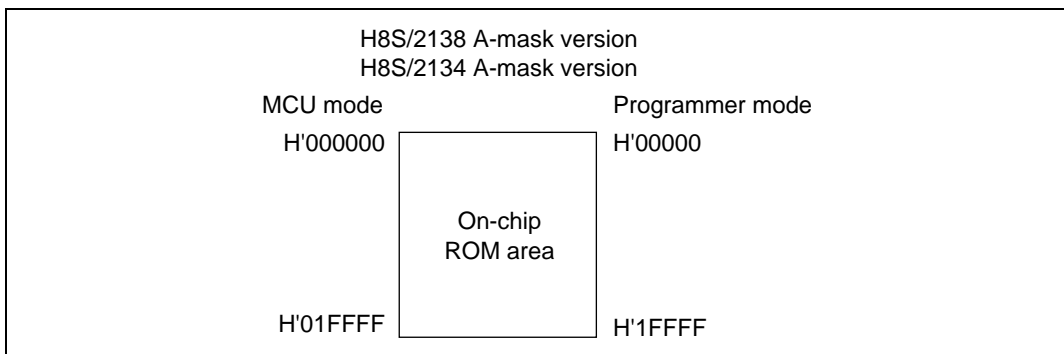


Figure 22.15 Memory Map in Programmer Mode

22.10.3 Programmer Mode Operation

Table 22.11 shows how the different operating modes are set when using programmer mode, and table 22.12 lists the commands used in programmer mode. Details of each mode are given below.

- **Memory Read Mode**
Memory read mode supports byte reads.
- **Auto-Program Mode**
Auto-program mode supports programming of 128 bytes at a time. Status polling is used to confirm the end of auto-programming.
- **Auto-Erase Mode**
Auto-erase mode supports automatic erasing of the entire flash memory. Status polling is used to confirm the end of auto-erasing.
- **Status Read Mode**
Status polling is used for auto-programming and auto-erasing, and normal termination can be confirmed by reading the FO6 signal. In status read mode, error information is output if an error occurs.

Table 22.11 Settings for Each Operating Mode in Programmer Mode

| Mode | Pin Names | | | | |
|----------------------------|-----------------|-----------------|-----------------|-------------|-------------------|
| | \overline{CE} | \overline{OE} | \overline{WE} | FO7 to FO0 | FA17 to FA0 |
| Read | L | L | H | Data output | Ain ^{*2} |
| Output disable | L | H | H | Hi-Z | X |
| Command write | L | H | L | Data input | Ain ^{*2} |
| Chip disable ^{*1} | H | X | X | Hi-Z | X |

Notes: 1. Chip disable is not a standby state; internally, it is an operation state.

2. Ain indicates that there is also address input in auto-program mode.

Table 22.12 Programmer Mode Commands

| Command Name | Number of Cycles | 1st Cycle | | | 2nd Cycle | | |
|-------------------|------------------|-----------|---------|------|-----------|---------|------|
| | | Mode | Address | Data | Mode | Address | Data |
| Memory read mode | 1 + n | Write | X | H'00 | Read | RA | Dout |
| Auto-program mode | 129 | Write | X | H'40 | Write | WA | Din |
| Auto-erase mode | 2 | Write | X | H'20 | Write | X | H'20 |
| Status read mode | 2 | Write | X | H'71 | Write | X | H'71 |

Notes: 1. In auto-program mode, 129 cycles are required for command writing by a simultaneous 128-byte write.

2. In memory read mode, the number of cycles depends on the number of address write cycles (n).

22.10.4 Memory Read Mode

- After the end of an auto-program, auto-erase, or status read operation, the command wait state is entered. To read memory contents, a transition must be made to memory read mode by means of a command write before the read is executed.
- Command writes can be performed in memory read mode, just as in the command wait state.
- Once memory read mode has been entered, consecutive reads can be performed.
- After power-on, memory read mode is entered.

Table 22.13 AC Characteristics in Memory Read ModeConditions: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|------------|-----|-----|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

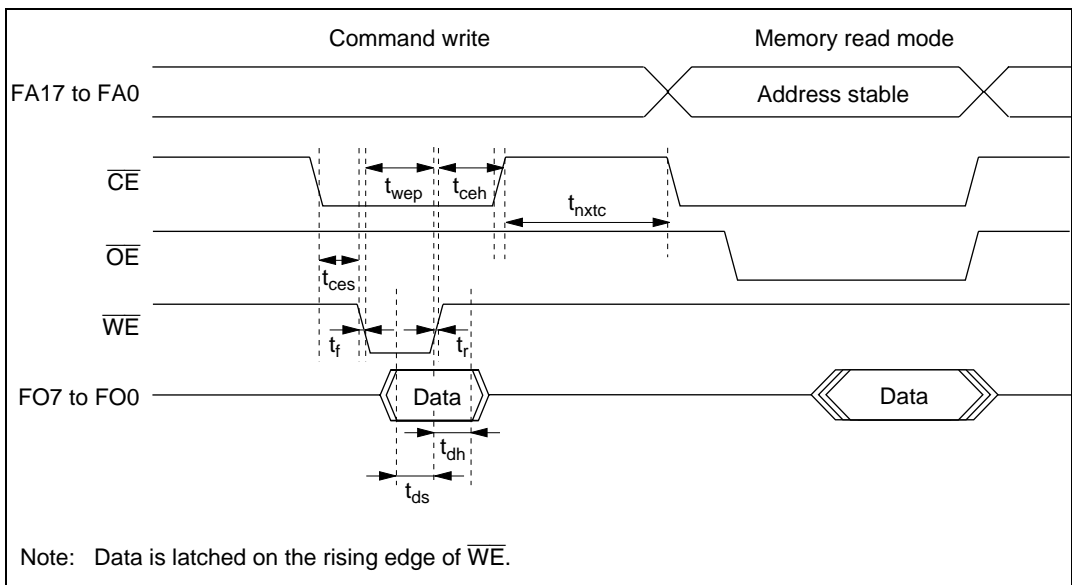
**Figure 22.16 Memory Read Mode Timing Waveforms after Command Write**

Table 22.14 AC Characteristics when Entering Another Mode from Memory Read ModeConditions: $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|------------|-----|-----|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

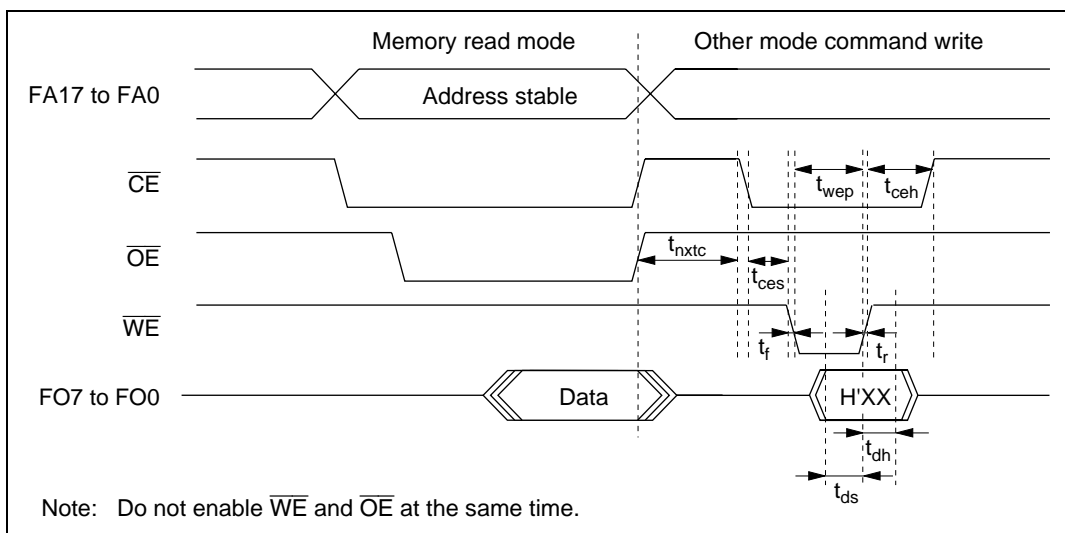
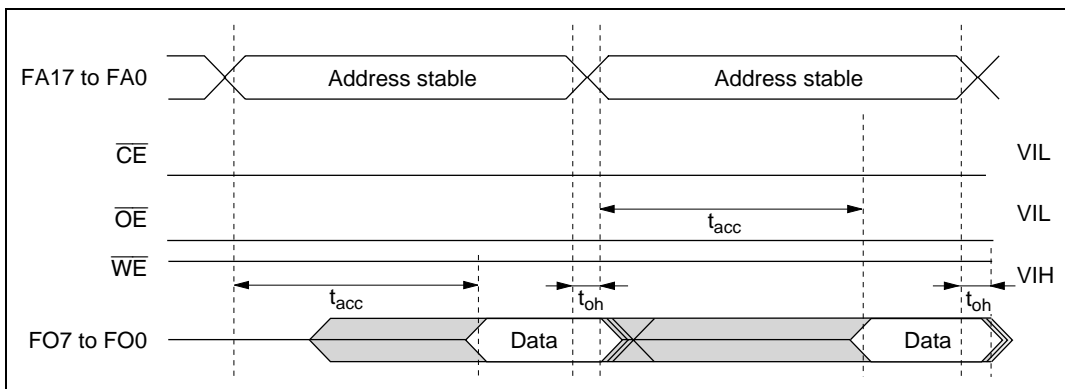
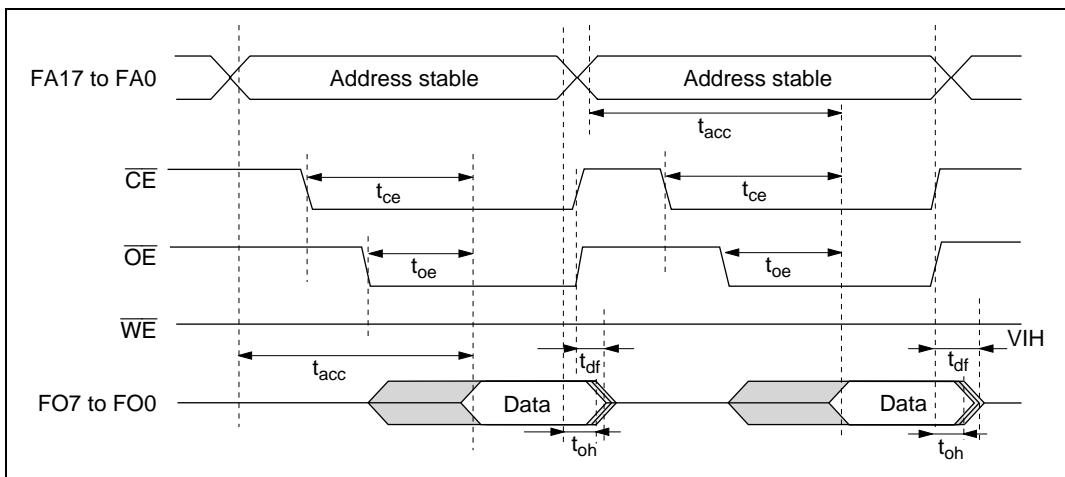
**Figure 22.17 Timing Waveforms when Entering Another Mode from Memory Read Mode**

Table 22.15 AC Characteristics in Memory Read ModeConditions: $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|--|-----------|-----|-----|---------------|
| Access time | t_{acc} | — | 20 | μs |
| $\overline{\text{CE}}$ output delay time | t_{ce} | — | 150 | ns |
| $\overline{\text{OE}}$ output delay time | t_{oe} | — | 150 | ns |
| Output disable delay time | t_{df} | — | 100 | ns |
| Data output hold time | t_{oh} | 5 | — | ns |

**Figure 22.18 Timing Waveforms for $\overline{\text{CE}}/\overline{\text{OE}}$ Enable State Read****Figure 22.19 Timing Waveforms for $\overline{\text{CE}}/\overline{\text{OE}}$ Clocked Read**

22.10.5 Auto-Program Mode

AC Characteristics

Table 22.16 AC Characteristics in Auto-Program Mode

Conditions: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|-------------|-----|------|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| Status polling start time | t_{wsts} | 1 | — | ms |
| Status polling access time | t_{spa} | — | 150 | ns |
| Address setup time | t_{as} | 0 | — | ns |
| Address hold time | t_{ah} | 60 | — | ns |
| Memory write time | t_{write} | 1 | 3000 | ms |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

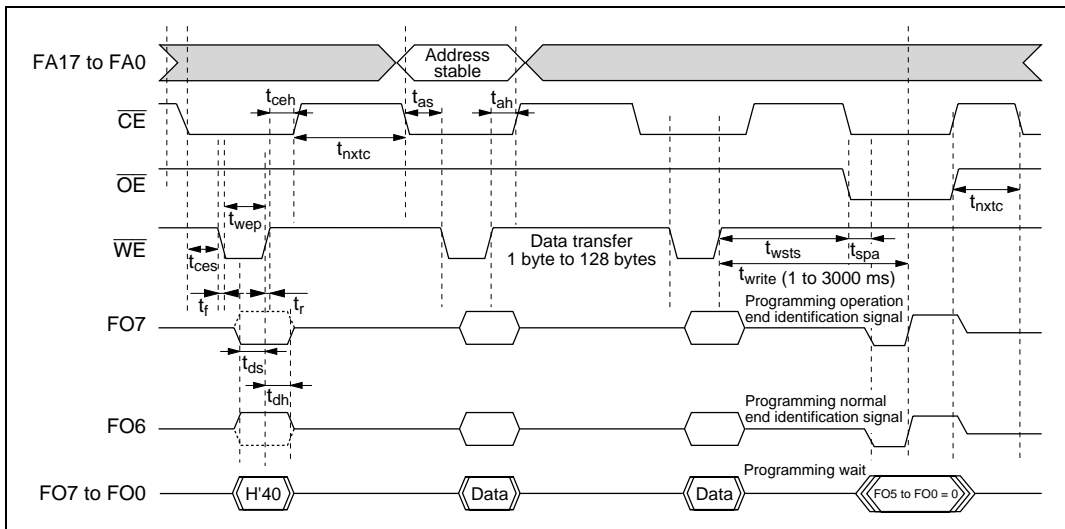


Figure 22.20 Auto-Program Mode Timing Waveforms

Notes on Use of Auto-Program Mode

- In auto-program mode, 128 bytes are programmed simultaneously. This should be carried out by executing 128 consecutive byte transfers.
- A 128-byte data transfer is necessary even when programming fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
- The lower 8 bits of the transfer address must be H'00 or H'80. If a value other than an effective address is input, processing will switch to a memory write operation but a write error will be flagged.
- Memory address transfer is performed in the second cycle (figure 22.20). Do not perform transfer after the second cycle.
- Do not perform a command write during a programming operation.
- Perform one auto-programming operation for a 128-byte block for each address. Characteristics are not guaranteed for two or more programming operations.
- Confirm normal end of auto-programming by checking FO6. Alternatively, status read mode can also be used for this purpose (FO7 status polling uses the auto-program operation end identification pin).
- The status polling FO6 and FO7 pin information is retained until the next command write. Until the next command write is performed, reading is possible by enabling \overline{CE} and \overline{OE} .

22.10.6 Auto-Erase Mode

AC Characteristics

Table 22.17 AC Characteristics in Auto-Erase Mode

Conditions: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$

| Item | Symbol | Min | Max | Unit |
|-----------------------------------|-------------|-----|-------|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| Status polling start time | t_{ests} | 1 | — | ms |
| Status polling access time | t_{spa} | — | 150 | ns |
| Memory erase time | t_{erase} | 100 | 40000 | ms |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns |

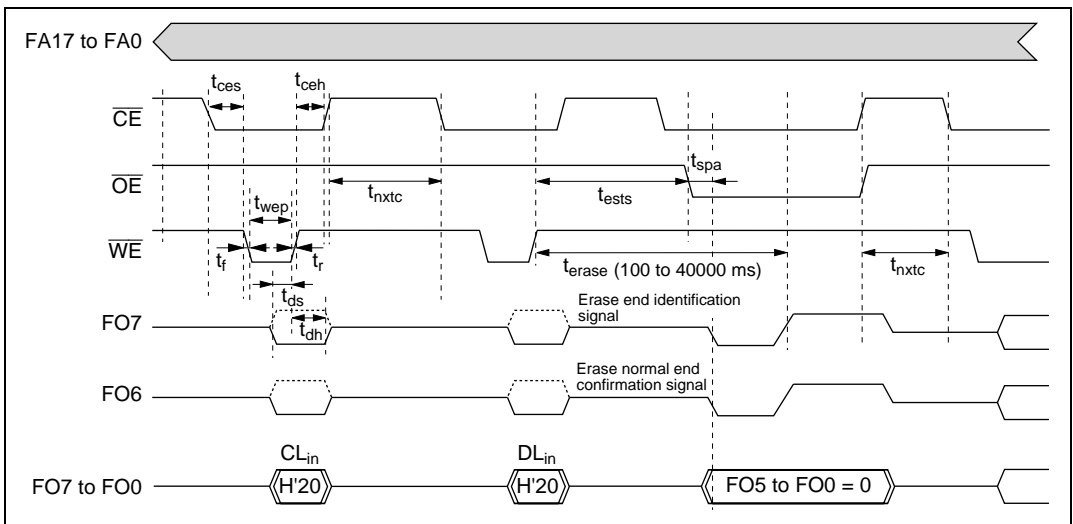


Figure 22.21 Auto-Erase Mode Timing Waveforms

Notes on Use of Auto-Erase-Program Mode

- Auto-erase mode supports only entire memory erasing.
- Do not perform a command write during auto-erasing.
- Confirm normal end of auto-erasing by checking FO6. Alternatively, status read mode can also be used for this purpose (FO7 status polling uses the auto-erase operation end identification pin).
- The status polling FO6 and FO7 pin information is retained until the next command write. Until the next command write is performed, reading is possible by enabling $\overline{\text{CE}}$ and $\overline{\text{OE}}$.

22.10.7 Status Read Mode

- Status read mode is used to identify what type of abnormal end has occurred. Use this mode when an abnormal end occurs in auto-program mode or auto-erase mode.
- The return code is retained until a command write for other than status read mode is performed.

Table 22.18 AC Characteristics in Status Read Mode

Conditions: $V_{\text{CC}} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{\text{SS}} = 0 \text{ V}$, $T_{\text{a}} = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$

| Item | Symbol | Min | Max | Unit |
|--|-------------------|-----|-----|---------------|
| Command write cycle | t_{nxtc} | 20 | — | μs |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns |
| Data hold time | t_{dh} | 50 | — | ns |
| Data setup time | t_{ds} | 50 | — | ns |
| Write pulse width | t_{wep} | 70 | — | ns |
| $\overline{\text{OE}}$ output delay time | t_{oe} | — | 150 | ns |
| Disable delay time | t_{df} | — | 100 | ns |
| $\overline{\text{CE}}$ output delay time | t_{ce} | — | 150 | ns |
| $\overline{\text{WE}}$ rise time | t_{r} | — | 30 | ns |
| $\overline{\text{WE}}$ fall time | t_{f} | — | 30 | ns |

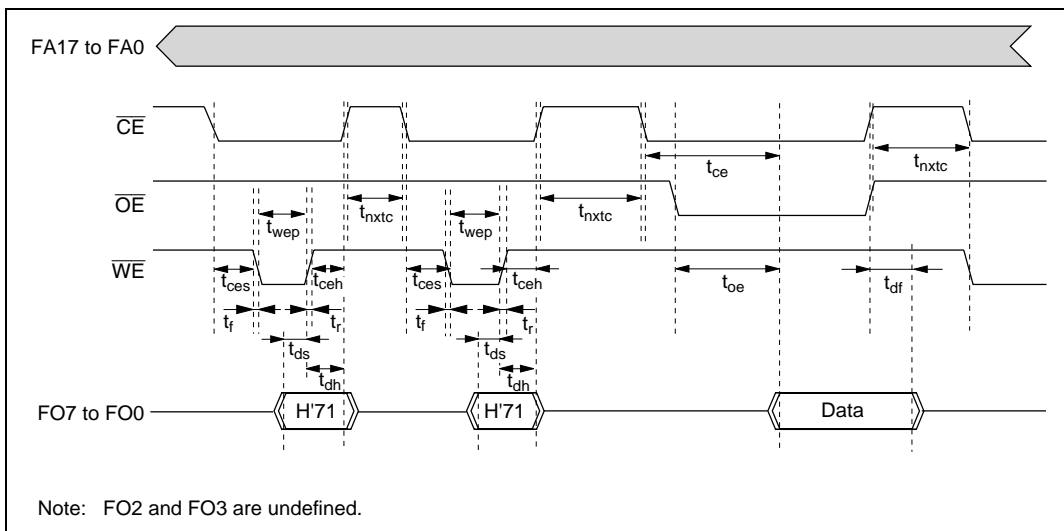


Figure 22.22 Status Read Mode Timing Waveforms

Table 22.19 Status Read Mode Return Commands

| Pin Name | FO7 | FO6 | FO5 | FO4 | FO3 | FO2 | FO1 | FO0 |
|---------------|----------------------------------|----------------------------------|--------------------------------------|--------------------------------|-----|-----|-------------------------------------|--|
| Attribute | Normal end identification | Command error | Programming error | Erase error | — | — | Programming or erase count exceeded | Effective address error |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Indications | Normal end: 0 Abnormal end: 1 | Command error: 1 Otherwise: 0 | Programming error: 1 Otherwise: 0 | Erase error: 1 Otherwise: 0 | — | — | Count exceeded: 1 Otherwise: 0 | Effective address error: 1 Otherwise: 0 |

Note: FO2 and FO3 are undefined.

22.10.8 Status Polling

- The FO7 status polling flag indicates the operating status in auto-program or auto-erase mode.
- The FO6 status polling flag indicates a normal or abnormal end in auto-program or auto-erase mode.

Table 22.20 Status Polling Output Truth Table

| Pin Names | Internal Operation in Progress | Abnormal End | — | Normal End |
|------------|--------------------------------|--------------|---|------------|
| FO7 | 0 | 1 | 0 | 1 |
| FO6 | 0 | 0 | 1 | 1 |
| FO0 to FO5 | 0 | 0 | 0 | 0 |

22.10.9 Programmer Mode Transition Time

Commands cannot be accepted during the oscillation stabilization period or the programmer mode setup period. After the programmer mode setup time, a transition is made to memory read mode.

Table 22.21 Command Wait State Transition Time Specifications

| Item | Symbol | Min | Max | Unit |
|--|------------|-----|-----|------|
| Standby release (oscillation stabilization time) | t_{osc1} | 20 | — | ms |
| Programmer mode setup time | t_{bmv} | 10 | — | ms |
| V_{cc} hold time | t_{dwn} | 0 | — | ms |

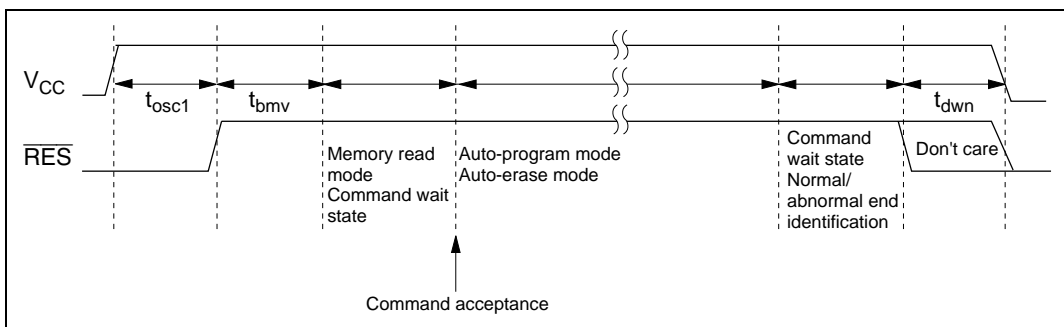


Figure 22.23 Oscillation Stabilization Time, Programmer Mode Setup Time, and Power Supply Fall Sequence

22.10.10 Notes on Memory Programming

- When programming addresses which have previously been programmed, carry out auto-erasing before auto-programming.
- When performing programming using programmer mode on a chip that has been programmed/erased in an on-board programming mode, auto-erasing is recommended before carrying out auto-programming.

Notes: 1. The flash memory is initially in the erased state when the device is shipped by Renesas. For other chips for which the erasure history is unknown, it is recommended that auto-erasing be executed to check and supplement the initialization (erase) level.

2. Auto-programming should be performed once only on the same address block.

22.11 Flash Memory Programming and Erasing Precautions

Precautions concerning the use of on-board programming mode and programmer mode are summarized below.

Use the specified voltages and timing for programming and erasing: Applied voltages in excess of the rating can permanently damage the device. For a PROM programmer, use Renesas Technology microcomputer device types with 128-kbyte on-chip flash memory that support a 3.3 V programming voltage.

Do not select the HN28F101 or use a programming voltage of 5.0 V for the PROM programmer, and only use the specified socket adapter. Incorrect use will result in damaging the device.

Powering on and off: When applying or disconnecting V_{cc} , fix the \overline{RES} pin low and place the flash memory in the hardware protection state.

The power-on and power-off timing requirements should also be satisfied in the event of a power failure and subsequent recovery.

Use the recommended algorithm when programming and erasing flash memory: The recommended algorithm enables programming and erasing to be carried out without subjecting the device to voltage stress or sacrificing program data reliability. When setting the P or E bit in FLMCR1, the watchdog timer should be set beforehand as a precaution against program runaway, etc.

Do not set or clear the SWE bit during program execution in flash memory. Wait for at least 100 μ s after clearing the SWE bit before executing a program or reading data in flash memory. When the SWE bit is set, data in flash memory can be rewritten, but when SWE = 1 the flash memory can only be read in program-verify or erase-verify mode. Flash memory should only be

accessed for verify operations (verification during programming/erasing). Do not clear the SWE bit during a program, erase, or verify operation.

Do not use interrupts while flash memory is being programmed or erased: All interrupt requests, including NMI, should be disabled when programming and erasing flash memory to give priority to program/erase operations.

Do not perform additional programming. Erase the memory before reprogramming. In on-board programming, perform only one programming operation on a 128-byte programming unit block. In programmer mode, too, perform only one programming operation on a 128-byte programming unit block. Programming should be carried out with the entire programming unit block erased.

Before programming, check that the chip is correctly mounted in the PROM programmer. Overcurrent damage to the device can result if the index marks on the PROM programmer socket, socket adapter, and chip are not correctly aligned.

Do not touch the socket adapter or chip during programming. Touching either of these can cause contact faults and write errors.

22.12 Note on Switching from F-ZTAT Version to Mask ROM Version

The mask ROM version does not have the internal register for flash memory control that are provided in the F-ZTAT version. Table 22.22 lists the registers that are present in the F-ZTAT version but not in the mask ROM version. If a register listed in table 22.22 is read in the mask ROM version, an undefined value will be returned. Therefore, if application software developed on the F-ZTAT version is switched to a mask ROM version products, it must be modified to ensure that the registers in table 22.22 have no effect.

Table 22.22 Registers Present in F-ZTAT Version but Absent in Mask ROM Version

| Register | Abbreviation | Address |
|---------------------------------|--------------|---------|
| Flash memory control register 1 | FLMCR1 | H'FF80 |
| Flash memory control register 2 | FLMCR2 | H'FF81 |
| Erase block register 1 | EBR1 | H'FF82 |
| Erase block register 2 | EBR2 | H'FF83 |

Section 23 Clock Pulse Generator

23.1 Overview

The H8S/2138 Group and H8S/2134 Group have an on-chip clock pulse generator (CPG) that generates the system clock (ϕ), the bus master clock, and internal clocks.

The clock pulse generator consists of an oscillator circuit, a duty adjustment circuit, clock selection circuit, medium-speed clock divider, bus master clock selection circuit, subclock input circuit, and waveform shaping circuit.

23.1.1 Block Diagram

Figure 23.1 shows a block diagram of the clock pulse generator.

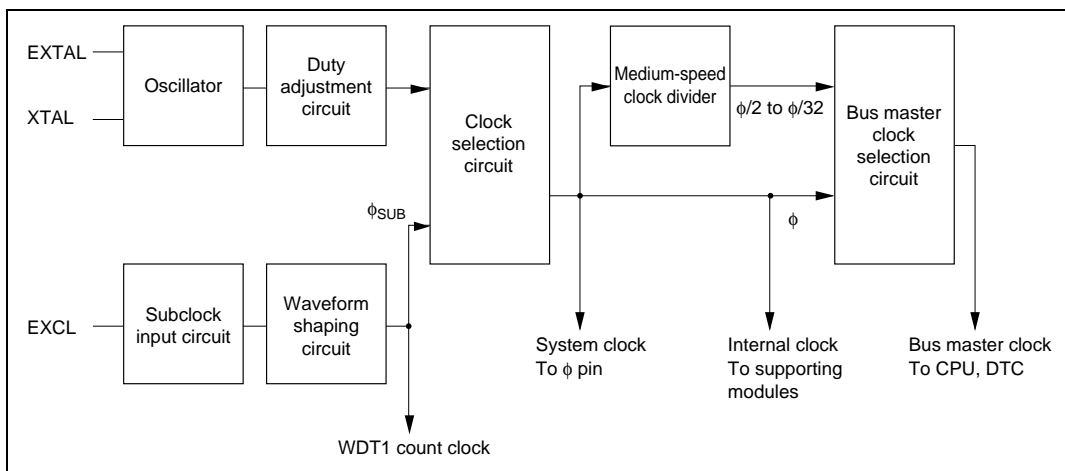


Figure 23.1 Block Diagram of Clock Pulse Generator

23.1.2 Register Configuration

The clock pulse generator is controlled by the standby control register (SBYCR) and low-power control register (LPWRCR). Table 23.1 shows the register configuration.

Table 23.1 CPG Registers

| Name | Abbreviation | R/W | Initial Value | Address* |
|----------------------------|--------------|-----|---------------|----------|
| Standby control register | SBYCR | R/W | H'00 | H'FF84 |
| Low-power control register | LPWRCR | R/W | H'00 | H'FF85 |

Note: * Lower 16 bits of the address.

23.2 Register Descriptions

23.2.1 Standby Control Register (SBYCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|---|------|------|------|
| | SSBY | STS2 | STS1 | STS0 | — | SCK2 | SCK1 | SCK0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | — | R/W | R/W | R/W |

SBYCR is an 8-bit readable/writable register that performs power-down mode control.

Only bits 0 to 2 are described here. For a description of the other bits, see section 24.2.1, Standby Control Register (SBYCR).

SBYCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 2 to 0—System Clock Select 2 to 0 (SCK2 to SCK0): These bits select the bus master clock for high-speed mode and medium-speed mode.

When operating the device after a transition to subactive mode or watch mode bits SCK2 to SCK0 should all be cleared to 0.

| Bit 2 | Bit 1 | Bit 0 | Description |
|-------|-------|-------|--|
| SCK2 | SCK1 | SCK0 | |
| 0 | 0 | 0 | Bus master is in high-speed mode (Initial value) |
| | | 1 | Medium-speed clock is $\phi/2$ |
| | 1 | 0 | Medium-speed clock is $\phi/4$ |
| | | 1 | Medium-speed clock is $\phi/8$ |
| 1 | 0 | 0 | Medium-speed clock is $\phi/16$ |
| | | 1 | Medium-speed clock is $\phi/32$ |
| | 1 | — | — |

23.2.2 Low-Power Control Register (LPWRCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|---|---|---|---|
| | DTON | LSON | NESEL | EXCLE | — | — | — | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | — | — | — | — |

LPWRCR is an 8-bit readable/writable register that performs power-down mode control.

Only bit 4 is described here. For a description of the other bits, see section 24.2.2, Low-Power Control Register (LPWRCR).

LPWRCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 4—Subclock Input Enable (EXCLE): Controls subclock input from the EXCL pin.

Bit 4

| EXCLE | Description |
|-------|--|
| 0 | Subclock input from EXCL pin is disabled (Initial value) |
| 1 | Subclock input from EXCL pin is enabled |

23.3 Oscillator

Clock pulses can be supplied by connecting a crystal resonator, or by input of an external clock.

23.3.1 Connecting a Crystal Resonator

Circuit Configuration: A crystal resonator can be connected as shown in the example in figure 23.2. Select the damping resistance R_d according to table 23.2. An AT-cut parallel-resonance crystal should be used.

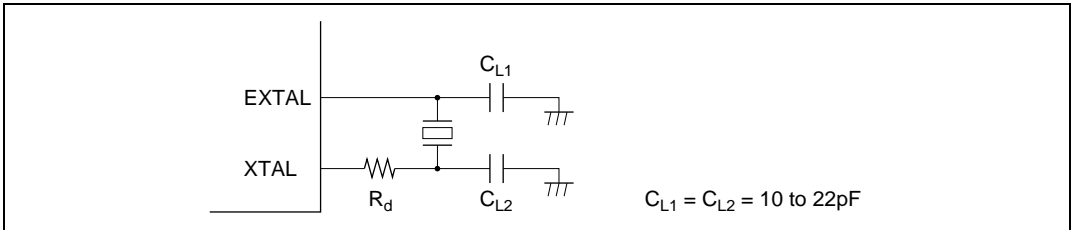


Figure 23.2 Connection of Crystal Resonator (Example)

Table 23.2 Damping Resistance Value

| Frequency (MHz) | 2 | 4 | 8 | 10 | 12 | 16 | 20 |
|--------------------|----|-----|-----|----|----|----|----|
| R_d (Ω) | 1k | 500 | 200 | 0 | 0 | 0 | 0 |

Crystal resonator: Figure 23.3 shows the equivalent circuit of the crystal resonator. Use a crystal resonator that has the characteristics shown in table 23.3 and the same frequency as the system clock (ϕ).

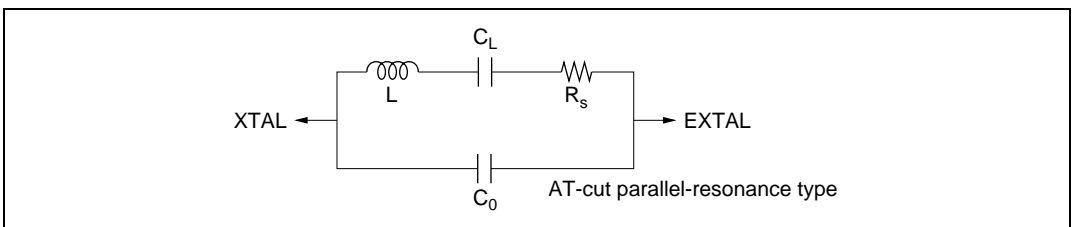


Figure 23.3 Crystal Resonator Equivalent Circuit

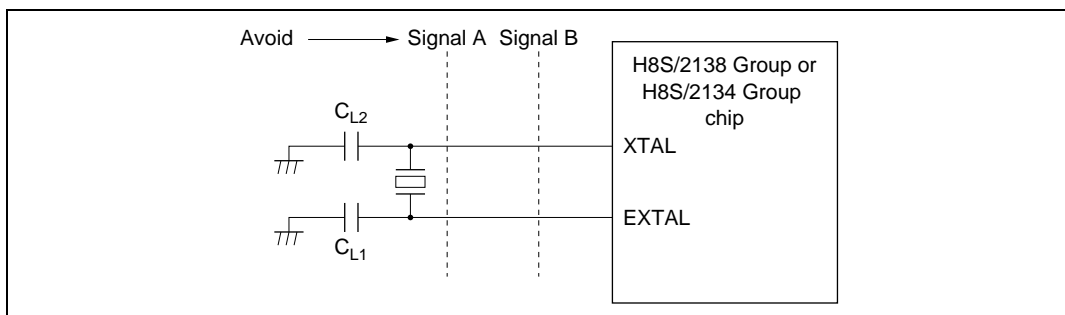
Table 23.3 Crystal Resonator Parameters

| Frequency (MHz) | 2 | 4 | 8 | 10 | 12 | 16 | 20 |
|------------------------|-----|-----|----|----|----|----|----|
| R_s max (Ω) | 500 | 120 | 80 | 70 | 60 | 50 | 40 |
| C_0 max (pF) | 7 | 7 | 7 | 7 | 7 | 7 | 7 |

Note on Board Design: When a crystal resonator is connected, the following points should be noted.

Other signal lines should be routed away from the oscillator circuit to prevent induction from interfering with correct oscillation. See figure 23.4.

When designing the board, place the crystal resonator and its load capacitors as close as possible to the XTAL and EXTAL pins.

**Figure 23.4 Example of Incorrect Board Design**

23.3.2 External Clock Input

Circuit Configuration: An external clock signal can be input as shown in the examples in figure 23.5. If the XTAL pin is left open, make sure that stray capacitance is no more than 10 pF.

In example (b), make sure that the external clock is held high in standby mode, subactive mode, subsleep mode, and watch mode.

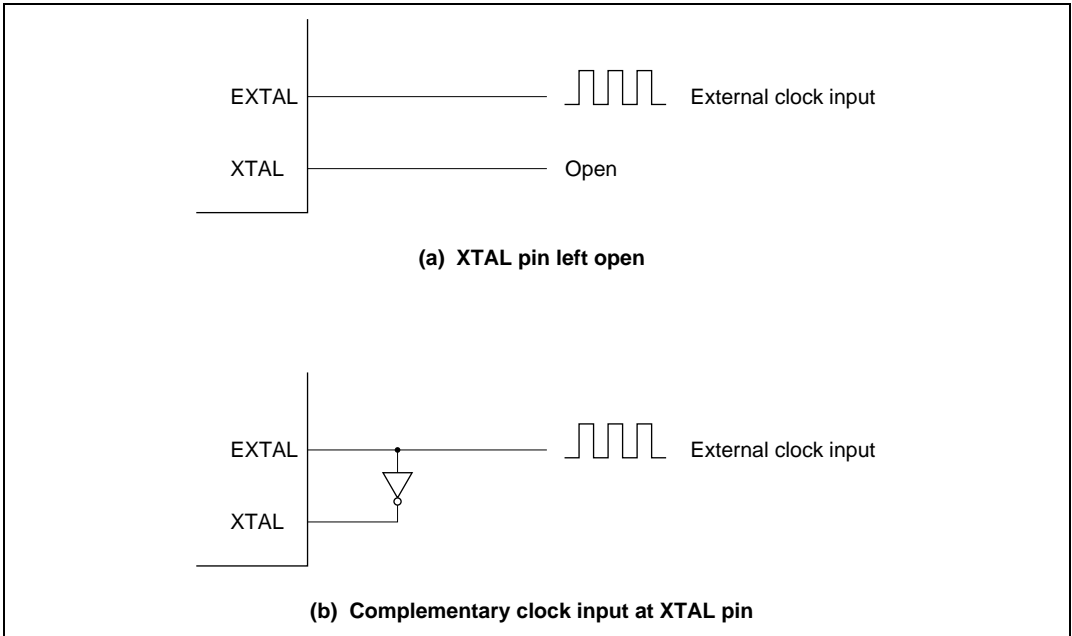


Figure 23.5 External Clock Input (Examples)

External Clock: The external clock signal should have the same frequency as the system clock (ϕ).

Table 23.4 and figure 23.6 show the input conditions for the external clock.

Table 23.4 External Clock Input Conditions

| Item | Symbol | $V_{CC} = 2.7 \text{ to } 5.5 \text{ V}$ | | $V_{CC} = 5.0 \text{ V} \pm 10\%$ | | Unit | Test Conditions | |
|---------------------------------------|-----------|--|-----|-----------------------------------|-----|-----------|---------------------------|-------------|
| | | Min | Max | Min | Max | | | |
| External clock input low pulse width | t_{EXL} | 40 | — | 20 | — | ns | Figure 23.6 | |
| External clock input high pulse width | t_{EXH} | 40 | — | 20 | — | ns | | |
| External clock rise time | t_{EXr} | — | 10 | — | 5 | ns | | |
| External clock fall time | t_{EXf} | — | 10 | — | 5 | ns | | |
| Clock low pulse width | t_{CL} | 0.4 | 0.6 | 0.4 | 0.6 | t_{cyc} | $\phi \geq 5 \text{ MHz}$ | Figure 25.5 |
| | | 80 | — | 80 | — | ns | $\phi < 5 \text{ MHz}$ | |
| Clock high pulse width | t_{CH} | 0.4 | 0.6 | 0.4 | 0.6 | t_{cyc} | $\phi \geq 5 \text{ MHz}$ | |
| | | 80 | — | 80 | — | ns | $\phi < 5 \text{ MHz}$ | |

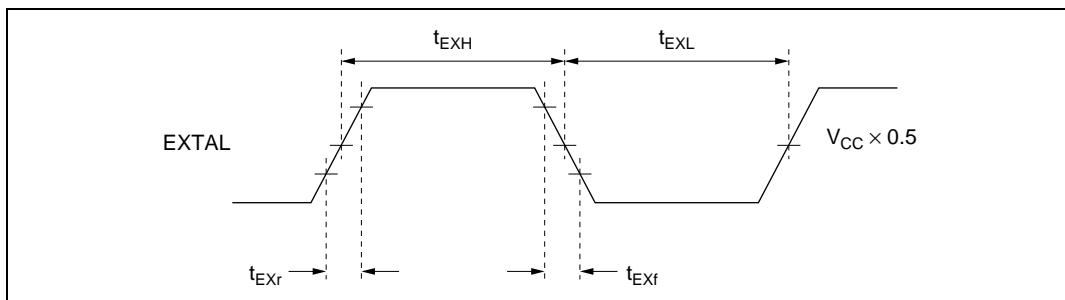
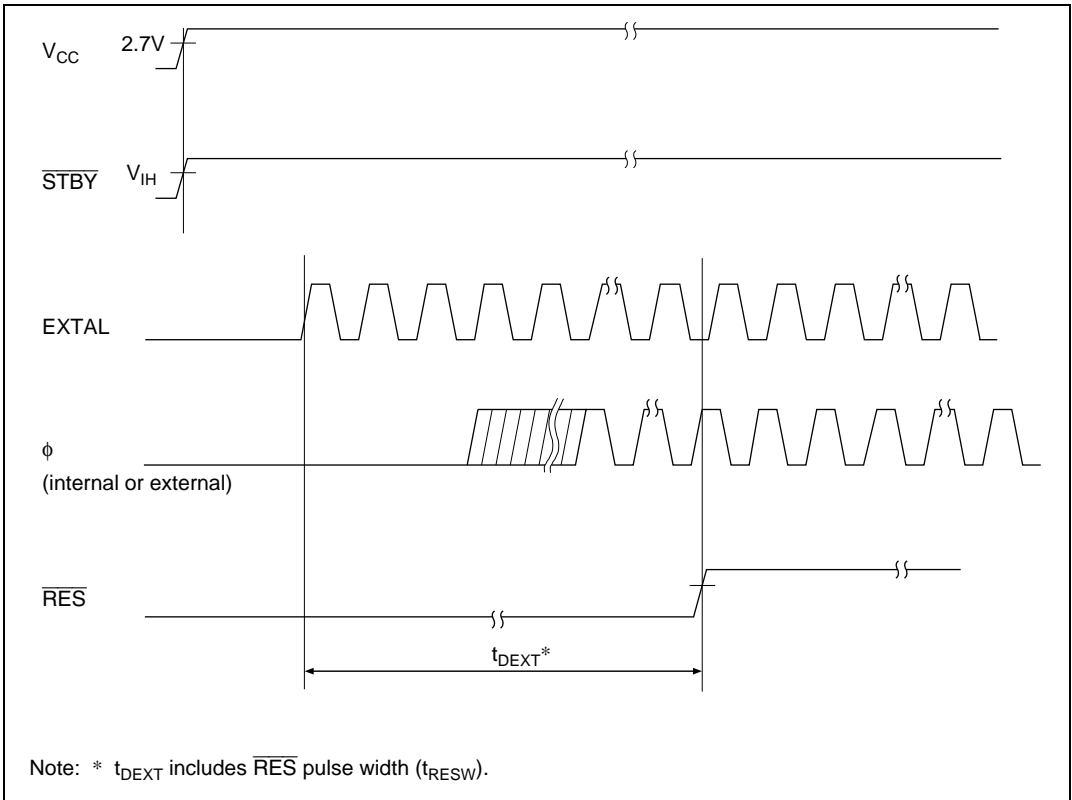
**Figure 23.6 External Clock Input Timing**

Table 23.5 shows the external clock output settling delay time, and figure 23.7 shows the external clock output settling delay timing. The oscillator and duty adjustment circuit have a function for adjusting the waveform of the external clock input at the EXTAL pin. When the prescribed clock signal is input at the EXTAL pin, internal clock signal output is fixed after the elapse of the external clock output settling delay time (t_{DEXT}). As the clock signal output is not fixed during the t_{DEXT} period, the reset signal should be driven low to maintain the reset state.

Table 23.5 External Clock Output Settling Delay TimeConditions: $V_{CC} = 2.7\text{ V to } 5.5\text{ V}$, $AV_{CC} = 2.7\text{ V to } 5.5\text{ V}$, $V_{SS} = AV_{SS} = 0\text{ V}$

| Item | Symbol | Min | Max | Unit | Notes |
|---|---------------------|-----|-----|---------------|-------------|
| External clock output settling delay time | t_{DEXT}^* | 500 | — | μs | Figure 23.7 |

Note: * t_{DEXT} includes $\overline{\text{RES}}$ pulse width (t_{RESW}).**Figure 23.7 External Clock Output Settling Delay Timing**

23.4 Duty Adjustment Circuit

When the oscillator frequency is 5 MHz or higher, the duty adjustment circuit adjusts the duty cycle of the clock signal from the oscillator to generate the system clock (ϕ).

23.5 Medium-Speed Clock Divider

The medium-speed clock divider divides the system clock to generate $\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, and $\phi/32$ clocks.

23.6 Bus Master Clock Selection Circuit

The bus master clock selection circuit selects the system clock (ϕ) or one of the medium-speed clocks ($\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, or $\phi/32$) to be supplied to the bus master, according to the settings of bits SCK2 to SCK0 in SBYCR.

23.7 Subclock Input Circuit

The subclock input circuit controls the subclock input from the EXCL pin.

Inputting the Subclock: When a subclock is used, a 32.768-kHz external clock should be input from the EXCL pin. In this case, clear bit P96DDR to 0 in P9DDR and set bit EXCLE to 1 in LPWRCR.

The subclock input conditions are shown in table 23.6 and figure 23.8.

Table 23.6 Subclock Input Conditions

| Item | Symbol | $V_{CC} = 2.7 \text{ to } 5.5 \text{ V}$ | | | Unit | Test Conditions |
|---------------------------------|-------------|--|-------|-----|---------------|-----------------|
| | | Min | Typ | Max | | |
| Subclock input low pulse width | t_{EXCLL} | — | 15.26 | — | μs | Figure 23.8 |
| Subclock input high pulse width | t_{EXCLH} | — | 15.26 | — | μs | |
| Subclock input rise time | t_{EXCLr} | — | — | 10 | ns | |
| Subclock input fall time | t_{EXCLf} | — | — | 10 | ns | |

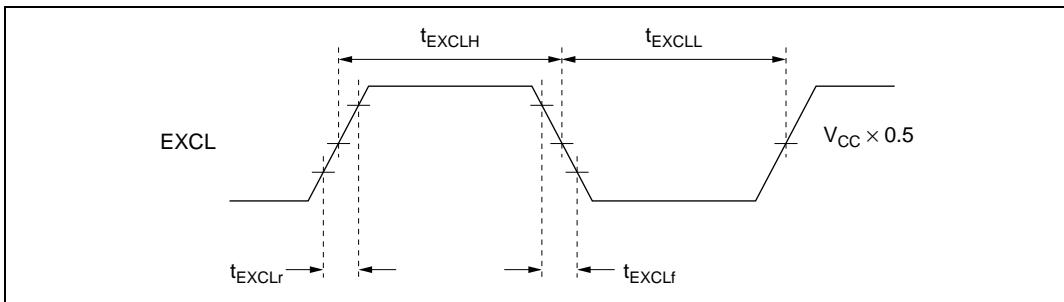


Figure 23.8 Subclock Input Timing

When Subclock Is Not Needed: Do not enable subclock input when the subclock is not needed.

Note on Subclock Usage: In transitioning to power-down mode, if at least two cycles of the 32-kHz clock are not input after the 32-kHz clock input is enabled ($EXCLE = 1$) until the SLEEP instruction is executed (power-down mode transition), the subclock input circuit is not initialized and an error may occur in the microcomputer.

Before power-down mode is entered with using the subclock, at least two cycle of the 32-kHz clock should be input after the 32-kHz clock input is enabled ($EXCLE = 1$).

As described in the hardware manual (clock pulse generator/subclock input circuit), when the subclock is not used, the subclock input should not be enabled ($EXCLE = 0$).

23.8 Subclock Waveform Shaping Circuit

To eliminate noise in the subclock input from the EXCL pin, this circuit samples the clock using a clock obtained by dividing the ϕ clock. The sampling frequency is set with the NESEL bit in LPWRCR. For details, see section 24.2.2, Low-Power Control Register (LPWRCR). The clock is not sampled in subactive mode, subsleep mode, or watch mode.

23.9 Clock Selection Circuit

This circuit selects the system clock used in the MCU.

The clock signal generated in the EXTAL/XTAL pin oscillator is selected as the system clock when MCU is returned from high-speed mode, medium-speed mode, sleep mode, reset state, or standby mode.

In sub-active mode, sub-sleep mode, and watch mode, the sub-clock signal input from EXCL pin is selected as the system clock. In these modes, modules such as CPU, TMR0, TMR1, WDT0, WDT1, and I/O ports operate on the ϕ SUB clock. The count clock for each timer is a clock obtained by dividing the ϕ SUB clock.

Section 24 Power-Down State

24.1 Overview

In addition to the normal program execution state, the H8S/2138 Group and H8S/2134 Group have a power-down state in which operation of the CPU and oscillator is halted and power dissipation is reduced. Low-power operation can be achieved by individually controlling the CPU, on-chip supporting modules, and so on.

The H8S/2138 Group and H8S/2134 Group operating modes are as follows:

1. High-speed mode
2. Medium-speed mode
3. Subactive mode
4. Sleep mode
5. Subsleep mode
6. Watch mode
7. Module stop mode
8. Software standby mode
9. Hardware standby mode

Of these, 2 to 9 are power-down modes. Sleep mode and subsleep mode are CPU modes, medium-speed mode is a CPU and bus master mode, subactive mode is a CPU, bus master, and on-chip supporting module mode, and module stop mode is an on-chip supporting module mode (including bus masters other than the CPU). Certain combinations of these modes can be set.

After a reset, the MCU is in high-speed mode and module stop mode (excluding the DTC).

Table 24.1 shows the internal chip states in each mode, and table 24.2 shows the conditions for transition to the various modes. Figure 24.1 shows a mode transition diagram.

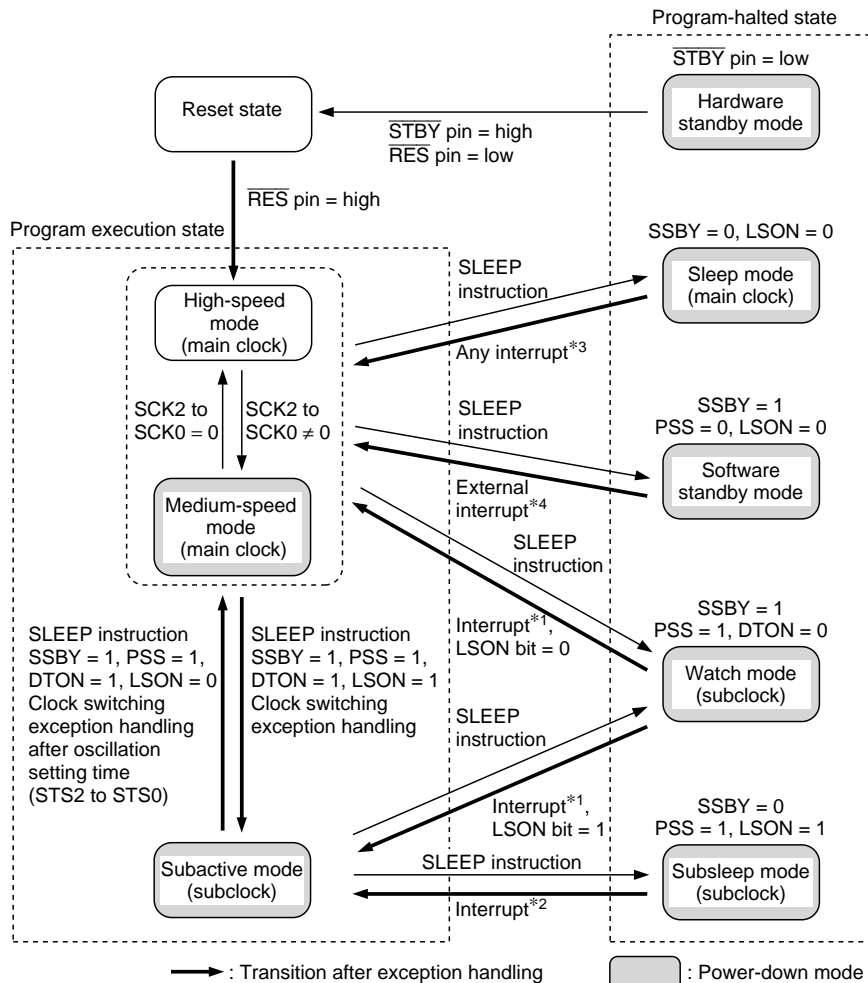
Table 24.1 H8S/2138 Group and H8S/2134 Group Internal States in Each Mode

| Function | High-Speed | Medium-Speed | Sleep | Module Stop | Watch | Subactive | Subsleep | Software Standby | Hardware Standby | |
|-------------------------------------|------------------|--------------|-------------------|-------------|-------------------------------|--------------------|--------------------|--------------------|-------------------|----------------|
| System clock oscillator | Functioning | Functioning | Functioning | Functioning | Halted | Halted | Halted | Halted | Halted | |
| Subclock input | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Halted | Halted | |
| CPU operation | Instructions | Functioning | Medium-speed | Halted | Functioning | Halted | Subclock operation | Halted | Halted | Halted |
| | Registers | Functioning | Medium-speed | Retained | Functioning | Retained | Subclock operation | Retained | Retained | Undefined |
| External interrupts | NMI | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Halted |
| | IRQ0 | | | | | | | | | |
| | IRQ1 | | | | | | | | | |
| | IRQ2 | | | | | | | | | |
| On-chip supporting module operation | DTC | Functioning | Medium-speed | Functioning | Functioning/halted (retained) | Halted (retained) | Halted (retained) | Halted (retained) | Halted (retained) | Halted (reset) |
| | WDT1 | Functioning | Functioning | Functioning | Functioning | Subclock operation | Subclock operation | Subclock operation | Halted (retained) | Halted (reset) |
| | WDT0 | Functioning | Functioning | Functioning | Functioning | Halted (retained) | Subclock operation | Subclock operation | Halted (retained) | Halted (reset) |
| | TMR0, 1 | Functioning | Functioning | Functioning | Functioning/halted (retained) | Halted (retained) | Subclock operation | Subclock operation | Halted (retained) | Halted (reset) |
| | FRT | Functioning | Functioning | Functioning | Functioning/halted (retained) | Halted (retained) | Halted (retained) | Halted (retained) | Halted (retained) | Halted (reset) |
| | TMRX, Y | | | | | | | | | |
| | Timer connection | | | | | | | | | |
| | IIC0 | | | | | | | | | |
| | IIC1 | | | | | | | | | |
| | SCI0 | Functioning | Functioning | Functioning | Functioning/halted (reset) | Halted (reset) | Halted (reset) | Halted (reset) | Halted (reset) | Halted (reset) |
| | SCI1 | | | | | | | | | |
| | SCI2 | | | | | | | | | |
| | PWM | | | | | | | | | |
| | PWMX | | | | | | | | | |
| | HIF | | | | | | | | | |
| | D/A | | | | | | | | | |
| | A/D | | | | | | | | | |
| RAM | Functioning | Functioning | Functioning (DTC) | Functioning | Retained | Functioning | Retained | Retained | Retained | |
| I/O | Functioning | Functioning | Functioning | Functioning | Retained | Functioning | Functioning | Retained | High impedance | |

Note: "Halted (retained)" means that internal register values are retained. The internal state is operation suspended.

"Halted (reset)" means that internal register values and internal states are initialized.

In module stop mode, only modules for which a stop setting has been made are halted (reset or retained).



Notes: When a transition is made between modes by means of an interrupt, transition cannot be made on interrupt source generation alone. Ensure that interrupt handling is performed after accepting the interrupt request.

From any state except hardware standby mode, a transition to the reset state occurs whenever $\overline{\text{RES}}$ goes low.

From any state, a transition to hardware standby mode occurs when $\overline{\text{STBY}}$ goes low.

When a transition is made to watch mode or subactive mode, high-speed mode must be set.

1. NMI, IRQ0 to IRQ2, IRQ6, IRQ7, and WDT1 interrupts
2. NMI, IRQ0 to RQ7, and WDT0 interrupts, WDT1 interrupt, TMR0 interrupt, TMR1 interrupt
3. All interrupts
4. NMI, IRQ0 to IRQ2, IRQ6, IRQ7

Figure 24.1 Mode Transitions

Table 24.2 Power-Down Mode Transition Conditions

| State before Transition | Control Bit States at Time of Transition | | | | State after Transition by SLEEP Instruction | State after Return by Interrupt |
|-----------------------------|---|-----|------|------|--|------------------------------------|
| | SSBY | PSS | LSON | DTON | | |
| High-speed/ medium-speed | 0 | * | 0 | * | Sleep | High-speed/ medium-speed |
| | 0 | * | 1 | * | — | — |
| | 1 | 0 | 0 | * | Software standby | High-speed/ medium-speed |
| | 1 | 0 | 1 | * | — | — |
| | 1 | 1 | 0 | 0 | Watch | High-speed |
| | 1 | 1 | 1 | 0 | Watch | Subactive |
| | 1 | 1 | 0 | 1 | — | — |
| | 1 | 1 | 1 | 1 | Subactive | — |
| Subactive | 0 | 0 | * | * | — | — |
| | 0 | 1 | 0 | * | — | — |
| | 0 | 1 | 1 | * | Subsleep | Subactive |
| | 1 | 0 | * | * | — | — |
| | 1 | 1 | 0 | 0 | Watch | High-speed |
| | 1 | 1 | 1 | 0 | Watch | Subactive |
| | 1 | 1 | 0 | 1 | High-speed | — |
| | 1 | 1 | 1 | 1 | — | — |

Legend:

*: Don't care

—: Do not set.

24.1.1 Register Configuration

The power-down state is controlled by the SBYCR, LPWRCCR, TCSR (WDT1), and MSTPCR registers. Table 24.3 summarizes these registers.

Table 24.3 Power-Down State Registers

| Name | Abbreviation | R/W | Initial Value | Address ^{*1} |
|--------------------------------------|--------------|-----|---------------|-----------------------|
| Standby control register | SBYCR | R/W | H'00 | H'FF84 ^{*2} |
| Low-power control register | LPWRCCR | R/W | H'00 | H'FF85 ^{*2} |
| Timer control/status register (WDT1) | TCSR | R/W | H'00 | H'FFEA |
| Module stop control register | MSTPCRH | R/W | H'3F | H'FF86 ^{*2} |
| | MSTPCRL | R/W | H'FF | H'FF87 ^{*2} |

Notes: 1. Lower 16 bits of the address.

2. Some power down state registers are assigned to the same address as other registers. In this case, register selection is performed by the FLSHE bit in the serial timer control register (STCR).

24.2 Register Descriptions

24.2.1 Standby Control Register (SBYCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|---|------|------|------|
| | SSBY | STS2 | STS1 | STS0 | — | SCK2 | SCK1 | SCK0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | — | R/W | R/W | R/W |

SBYCR is an 8-bit readable/writable register that performs power-down mode control.

SBYCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Software Standby (SSBY): Determines the operating mode, in combination with other control bits, when a power-down mode transition is made by executing a SLEEP instruction. The SSBY setting is not changed by a mode transition due to an interrupt, etc.

Bit 7

| SSBY | Description |
|------|---|
| 0 | Transition to sleep mode after execution of SLEEP instruction in high-speed mode or medium-speed mode (Initial value) Transition to subsleep mode after execution of SLEEP instruction in subactive mode |
| 1 | Transition to software standby mode, subactive mode, or watch mode after execution of SLEEP instruction in high-speed mode or medium-speed mode Transition to watch mode or high-speed mode after execution of SLEEP instruction in subactive mode |

Bits 6 to 4—Standby Timer Select 2 to 0 (STS2 to STS0): These bits select the time the MCU waits for the clock to stabilize when software standby mode, watch mode, or subactive mode is cleared and a transition is made to high-speed mode or medium-speed mode by means of a specific interrupt or instruction. With crystal oscillation, refer to table 24.5 and make a selection according to the operating frequency so that the standby time is at least 8 ms (the oscillation settling time). With an external clock, any selection can be made.

| Bit 6 | Bit 5 | Bit 4 | Description |
|-------|-------|-------|--|
| STS2 | STS1 | STS0 | |
| 0 | 0 | 0 | Standby time = 8192 states (Initial value) |
| | | 1 | Standby time = 16384 states |
| | 1 | 0 | Standby time = 32768 states |
| | | 1 | Standby time = 65536 states |
| 1 | 0 | 0 | Standby time = 131072 states |
| | | 1 | Standby time = 262144 states |
| | 1 | 0 | Reserved |
| | | 1 | Standby time = 16 states* |

Note: * Do not use this setting in the on-chip flash memory version.

Bit 3—Reserved: This bit cannot be modified and is always read as 0.

Bits 2 to 0—System Clock Select (SCK2 to SCK0): These bits select the clock for the bus master in high-speed mode and medium-speed mode. When operating the device after a transition to subactive mode or watch mode, bits SCK2 to SCK0 should all be cleared to 0.

| Bit 2 | Bit 1 | Bit 0 | Description | |
|-------|-------|-------|----------------------------------|-----------------|
| SCK2 | SCK1 | SCK0 | | |
| 0 | 0 | 0 | Bus master is in high-speed mode | (Initial value) |
| | | 1 | Medium-speed clock is $\phi/2$ | |
| | 1 | 0 | Medium-speed clock is $\phi/4$ | |
| 1 | 0 | 1 | Medium-speed clock is $\phi/8$ | |
| | | 1 | Medium-speed clock is $\phi/16$ | |
| | 1 | 1 | Medium-speed clock is $\phi/32$ | |
| 1 | 1 | — | — | |

24.2.2 Low-Power Control Register (LPWRCR)

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|---|---|---|---|
| | DTON | LSON | NESEL | EXCLE | — | — | — | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | — | — | — | — |

LPWRCR is an 8-bit readable/writable register that performs power-down mode control.

LPWRCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Direct-Transfer On Flag (DTON): Specifies whether a direct transition is made between high-speed mode, medium-speed mode, and subactive mode when making a power-down transition by executing a SLEEP instruction. The operating mode to which the transition is made after SLEEP instruction execution is determined by a combination of other control bits.

Bit 7

| DTON | Description |
|-------------|--|
| 0 | When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, software standby mode, or watch mode* When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode or watch mode (Initial value) |
| 1 | When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made directly to subactive mode*, or a transition is made to sleep mode or software standby mode When a SLEEP instruction is executed in subactive mode, a transition is made directly to high-speed mode, or a transition is made to subsleep mode |

Note: * When a transition is made to watch mode or subactive mode, high-speed mode must be set.

Bit 6—Low-Speed On Flag (LSON): Determines the operating mode in combination with other control bits when making a power-down transition by executing a SLEEP instruction. Also controls whether a transition is made to high-speed mode or to subactive mode when watch mode is cleared.

Bit 6

| LSON | Description |
|-------------|---|
| 0 | When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, software standby mode, or watch mode* When a SLEEP instruction is executed in subactive mode, a transition is made to watch mode, or directly to high-speed mode After watch mode is cleared, a transition is made to high-speed mode (Initial value) |
| 1 | When a SLEEP instruction is executed in high-speed mode a transition is made to watch mode or subactive mode* When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode or watch mode After watch mode is cleared, a transition is made to subactive mode |

Note: * When a transition is made to watch mode or subactive mode, high-speed mode must be set.

Bit 5—Noise Elimination Sampling Frequency Select (NESEL): Selects the frequency at which the subclock (ϕ_{SUB}) input from the EXCL pin is sampled with the clock (ϕ) generated by the system clock oscillator. When $\phi = 5$ MHz or higher, clear this bit to 0.

Bit 5

| NESEL | Description |
|-------|--|
| 0 | Sampling at ϕ divided by 32 (Initial value) |
| 1 | Sampling at ϕ divided by 4 |

Bit 4—Subclock Input Enable (EXCLE): Controls subclock input from the EXCL pin.

Bit 4

| EXCLE | Description |
|-------|--|
| 0 | Subclock input from EXCL pin is disabled (Initial value) |
| 1 | Subclock input from EXCL pin is enabled |

Bits 3 to 0—Reserved: These bits cannot be modified and are always read as 0.

24.2.3 Timer Control/Status Register (TCSR)

TCSR1

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|---------------------|-----|-----|-----------------------|------|------|------|
| | OVF | WT/ \overline{IT} | TME | PSS | RST/ \overline{NMI} | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Note: * Only 0 can be written in bit 7, to clear the flag.

TCSR1 is an 8-bit readable/writable register that performs selection of the WDT1 TCNT input clock, mode, etc.

Only bit 4 is described here. For details of the other bits, see section 14.2.2, Timer Control/Status Register (TCSR).

TCSR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 4—Prescaler Select (PSS): Selects the WDT1 TCNT input clock.

This bit also controls the operation in a power-down mode transition. The operating mode to which a transition is made after execution of a SLEEP instruction is determined in combination with other control bits.

For details, see the description of Clock Select 2 to 0 in section 14.2.2, Timer Control/Status Register (TCSR).

Bit 4

| PSS | Description |
|-----|---|
| 0 | TCNT counts ϕ -based prescaler (PSM) divided clock pulses When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode or software standby mode (Initial value) |
| 1 | TCNT counts ϕ SUB-based prescaler (PSM) divided clock pulses When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, watch mode*, or subactive mode* When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode, watch mode, or high-speed mode |

Note: * When a transition is made to watch mode or subactive mode, high-speed mode must be set.

24.2.4 Module Stop Control Register (MSTPCR)

| Bit | MSTPCR _H | | | | | | | | MSTPCR _L | | | | | | | |
|---------------|---------------------|-----|-----|-----|-----|-----|-----|-----|---------------------|-----|-----|-----|-----|-----|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

MSTPCR comprises two 8-bit readable/writable registers that perform module stop mode control.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTRCRH and MSTPCRL Bits 7 to 0—Module Stop (MSTP 15 to MSTP 0): These bits specify module stop mode. See table 24.4 for the method of selecting on-chip supporting modules.

**MSTPCRH, MSTPCRL
Bits 7 to 0**

| MSTP15 to MSTP0 | Description | |
|-----------------|-----------------------------|------------------------------------|
| 0 | Module stop mode is cleared | (Initial value of MSTP15, MSTP14) |
| 1 | Module stop mode is set | (Initial value of MSTP13 to MSTP0) |

24.3 Medium-Speed Mode

When the SCK2 to SCK0 bits in SBYCR are set to 1 in high-speed mode, the operating mode changes to medium-speed mode at the end of the bus cycle. In medium-speed mode, the CPU operates on the operating clock ($\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, or $\phi/32$) specified by the SCK2 to SCK0 bits. The bus master other than the CPU (the DTC) also operates in medium-speed mode. On-chip supporting modules other than the bus masters always operate on the high-speed clock (ϕ).

In medium-speed mode, a bus access is executed in the specified number of states with respect to the bus master operating clock. For example, if $\phi/4$ is selected as the operating clock, on-chip memory is accessed in 4 states, and internal I/O registers in 8 states.

Medium-speed mode is cleared by clearing all of bits SCK2 to SCK0 to 0. A transition is made to high-speed mode and medium-speed mode is cleared at the end of the current bus cycle.

If a SLEEP instruction is executed when the SSBY bit in SBYCR and the LSON bit in LPWRCR are cleared to 0, a transition is made to sleep mode. When sleep mode is cleared by an interrupt, medium-speed mode is restored.

If a SLEEP instruction is executed when the SSBY bit in SBYCR is set to 1, and the LSON bit in LPWRCR and the PSS bit in TCSR (WDT1) are both cleared to 0, a transition is made to software standby mode. When software standby mode is cleared by an external interrupt, medium-speed mode is restored.

When the $\overline{\text{RES}}$ pin is driven low, a transition is made to the reset state, and medium-speed mode is cleared. The same applies in the case of a reset caused by overflow of the watchdog timer.

When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

Figure 24.2 shows the timing for transition to and clearance of medium-speed mode.

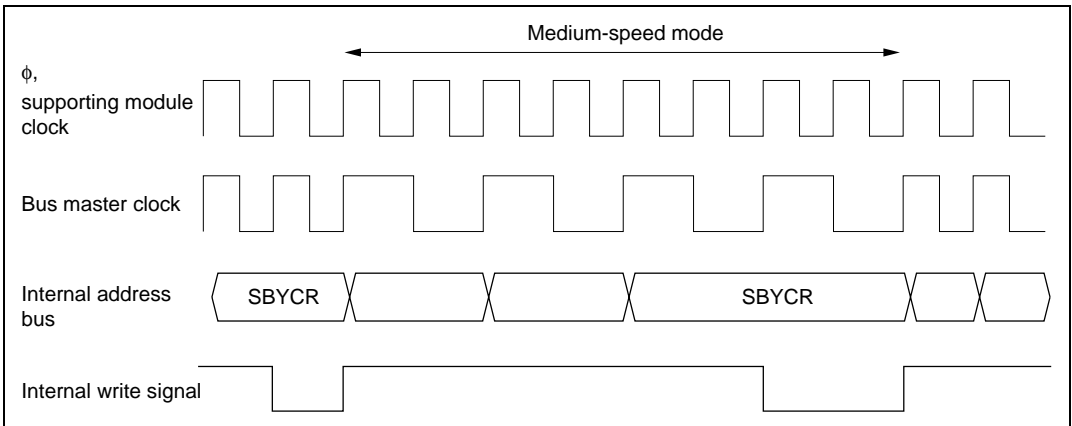


Figure 24.2 Medium-Speed Mode Transition and Clearance Timing

24.4 Sleep Mode

24.4.1 Sleep Mode

If a SLEEP instruction is executed when the SSBY bit in SBYCR and the LSON bit in LPWRCR are both cleared to 0, the CPU enters sleep mode. In sleep mode, CPU operation stops but the contents of the CPU's internal registers are retained. Other supporting modules do not stop.

24.4.2 Clearing Sleep Mode

Sleep mode is cleared by any interrupt, or with the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with an Interrupt: When an interrupt request signal is input, sleep mode is cleared and interrupt exception handling is started. Sleep mode will not be cleared if interrupts are disabled, or if interrupts other than NMI have been masked by the CPU.

Clearing with the $\overline{\text{RES}}$ Pin: When the $\overline{\text{RES}}$ pin is driven low, the reset state is entered. When the $\overline{\text{RES}}$ pin is driven high after the prescribed reset input period, the CPU begins reset exception handling.

Clearing with the $\overline{\text{STBY}}$ Pin: When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

24.5 Module Stop Mode

24.5.1 Module Stop Mode

Module stop mode can be set for individual on-chip supporting modules.

When the corresponding MSTP bit in MSTPCR is set to 1, module operation stops at the end of the bus cycle and a transition is made to module stop mode. The CPU continues operating independently.

Table 24.4 shows MSTP bits and the corresponding on-chip supporting modules.

When the corresponding MSTP bit is cleared to 0, module stop mode is cleared and the module starts operating again at the end of the bus cycle. In module stop mode, the internal states of modules other than the SCI, A/D converter, 8-bit PWM module, and 14-bit PWM module, are retained.

After reset release, all modules other than the DTC are in module stop mode.

When an on-chip supporting module is in module stop mode, read/write access to its registers is disabled.

Table 24.4 MSTP Bits and Corresponding On-Chip Supporting Modules

| Register | Bit | Module |
|----------|---------|--|
| MSTPCRH | MSTP15 | — |
| | MSTP14* | Data transfer controller (DTC) |
| | MSTP13 | 16-bit free-running timer (FRT) |
| | MSTP12 | 8-bit timers (TMR0, TMR1) |
| | MSTP11 | 8-bit PWM timer (PWM), 14-bit PWM timer (PWMX) |
| | MSTP10 | D/A converter |
| | MSTP9 | A/D converter |
| | MSTP8 | 8-bit timers (TMRX, TMRY), timer connection |
| MSTPCRL | MSTP7 | Serial communication interface 0 (SCI0) |
| | MSTP6 | Serial communication interface 1 (SCI1) |
| | MSTP5 | Serial communication interface 2 (SCI2) |
| | MSTP4* | I ² C bus interface (IIC) channel 0 (option) |
| | MSTP3* | I ² C bus interface (IIC) channel 1 (option) |
| | MSTP2 | Host interface (HIF), keyboard matrix interrupt mask register (KMIMR), port 6 MOS pull-up control register (KMPCR) |
| | MSTP1* | — |
| | MSTP0* | — |

Note: Do not set bits 15 to 1.

Bits 1 and 0 can be read or written to, but do not affect operation.

* Must be set to 1 in the H8S/2134 Group.

24.5.2 Usage Note

If there is conflict between DTC module stop mode setting and a DTC bus request, the bus request has priority and the MSTP bit will not be set to 1.

Write 1 to the MSTP bit again after the DTC bus cycle.

When using an H8S/2134 Group MCU, the MSTP bits for nonexistent modules must not be set to 1.

24.6 Software Standby Mode

24.6.1 Software Standby Mode

If a SLEEP instruction is executed when the SSBY bit in SBYCR is set to 1, the LSON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT1) is cleared to 0, software standby mode is entered. In this mode, the CPU, on-chip supporting modules, and oscillator all stop. However, the contents of the CPU's internal registers, RAM data, and the states of on-chip supporting modules other than the SCI, PWM, and PWMX, and of the I/O ports, are retained.

In this mode the oscillator stops, and therefore power dissipation is significantly reduced.

24.6.2 Clearing Software Standby Mode

Software standby mode is cleared by an external interrupt (NMI pin, or pin $\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$, $\overline{\text{IRQ2}}$, $\overline{\text{IRQ6}}$, or $\overline{\text{IRQ7}}$), or by means of the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with an Interrupt: When an NMI, IRQ0, IRQ1, IRQ2, IRQ6, or IRQ7 interrupt request signal is input, clock oscillation starts, and after the elapse of the time set in bits STS2 to STS0 in SYSCR, stable clocks are supplied to the entire chip, software standby mode is cleared, and interrupt exception handling is started.

Software standby mode cannot be cleared with an IRQ0, IRQ1, IRQ2, IRQ6, or IRQ7 interrupt if the corresponding enable bit has been cleared to 0 or has been masked by the CPU.

Clearing with the $\overline{\text{RES}}$ Pin: When the $\overline{\text{RES}}$ pin is driven low, clock oscillation is started. At the same time as clock oscillation starts, clocks are supplied to the entire chip. Note that the $\overline{\text{RES}}$ pin must be held low until clock oscillation stabilizes. When the $\overline{\text{RES}}$ pin goes high, the CPU begins reset exception handling.

Clearing with the $\overline{\text{STBY}}$ Pin: When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

24.6.3 Setting Oscillation Settling Time after Clearing Software Standby Mode

Bits STS2 to STS0 in SBYCR should be set as described below.

Using a Crystal Oscillator: Set bits STS2 to STS0 so that the standby time is at least 8 ms (the oscillation settling time).

Table 24.5 shows the standby times for different operating frequencies and settings of bits STS2 to STS0.

Table 24.5 Oscillation Settling Time Settings

| STS2 | STS1 | STS0 | Standby Time | 20 MHz | 16 MHz | 12 MHz | 10 MHz | 8 MHz | 6 MHz | 4 MHz | 2 MHz | Unit |
|------|------|------|---------------|--------|--------|--------|--------|-------|-------|-------|-------|------|
| 0 | 0 | 0 | 8192 states | 0.41 | 0.51 | 0.65 | 0.8 | 1.0 | 1.3 | 2.0 | 4.1 | ms |
| | | 1 | 16384 states | 0.82 | 1.0 | 1.3 | 1.6 | 2.0 | 2.7 | 4.1 | 8.2 | |
| | 1 | 0 | 32768 states | 1.6 | 2.0 | 2.7 | 3.3 | 4.1 | 5.5 | 8.2 | 16.4 | |
| | | 1 | 65536 states | 3.3 | 4.1 | 5.5 | 6.6 | 8.2 | 10.9 | 16.4 | 32.8 | |
| 1 | 0 | 0 | 131072 states | 6.6 | 8.2 | 10.9 | 13.1 | 16.4 | 21.8 | 32.8 | 65.5 | |
| | | 1 | 262144 states | 13.1 | 16.4 | 21.8 | 26.2 | 32.8 | 43.6 | 65.6 | 131.2 | |
| | 1 | 0 | Reserved | — | — | — | — | — | — | — | — | |
| | | 1 | 16 states* | 0.8 | 1.0 | 1.3 | 1.6 | 2.0 | 1.7 | 4.0 | 8.0 | μs |

: Recommended time setting

Note: * Do not used this setting in the on-chip flash memory version.

Using an External Clock: Any value can be set. Normally, use of the minimum time is recommended.

24.6.4 Software Standby Mode Application Example

Figure 24.3 shows an example in which a transition is made to software standby mode at the falling edge on the NMI pin, and software standby mode is cleared at the rising edge on the NMI pin.

In this example, an NMI interrupt is accepted with the NMIEG bit in SYSCR cleared to 0 (falling edge specification), then the NMIEG bit is set to 1 (rising edge specification), the SSBY bit is set to 1, and a SLEEP instruction is executed, causing a transition to software standby mode.

Software standby mode is then cleared at the rising edge on the NMI pin.

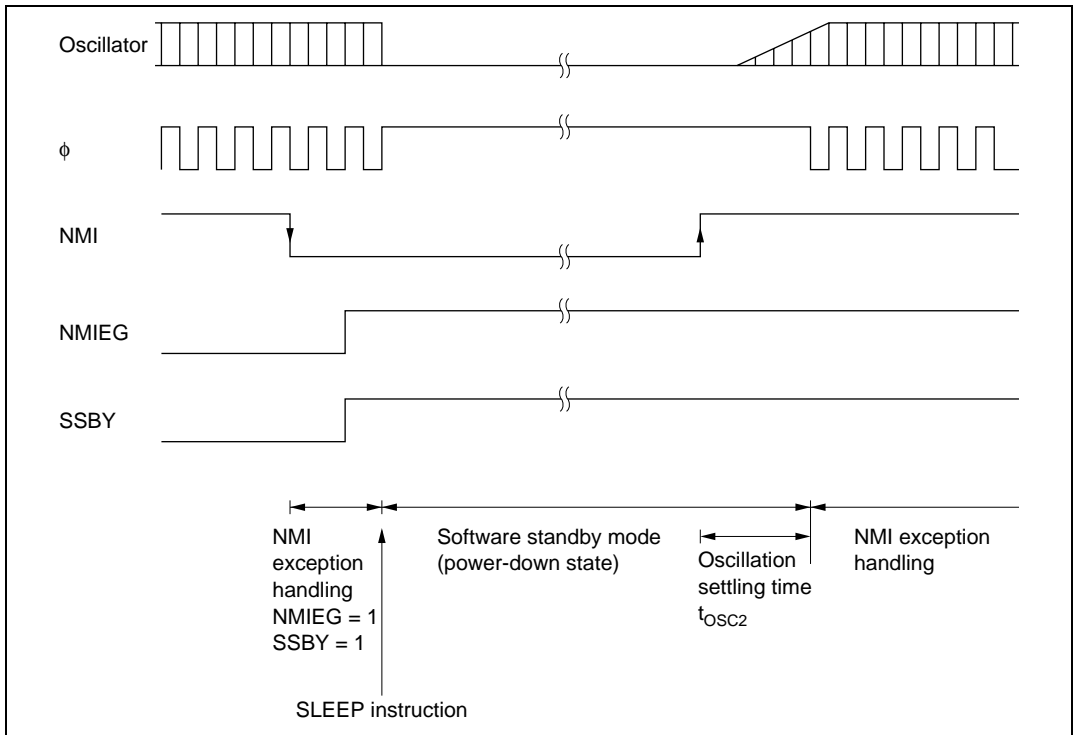


Figure 24.3 Software Standby Mode Application Example

24.6.5 Usage Note

In software standby mode, I/O port states are retained. Therefore, there is no reduction in current dissipation for the output current when a high-level signal is output.

Current dissipation increases while waiting for oscillation to settle.

24.7 Hardware Standby Mode

24.7.1 Hardware Standby Mode

When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode from any mode.

In hardware standby mode, all functions enter the reset state and stop operation, resulting in a significant reduction in power dissipation. As long as the prescribed voltage is supplied, on-chip RAM data is retained. I/O ports are set to the high-impedance state.

In order to retain on-chip RAM data, the RAME bit in SYSCR should be cleared to 0 before driving the $\overline{\text{STBY}}$ pin low.

Do not change the state of the mode pins (MD1 and MD0) while the chip is in hardware standby mode.

Hardware standby mode is cleared by means of the $\overline{\text{STBY}}$ pin and the $\overline{\text{RES}}$ pin. When the $\overline{\text{STBY}}$ pin is driven high while the $\overline{\text{RES}}$ pin is low, the reset state is set and clock oscillation is started. Ensure that the $\overline{\text{RES}}$ pin is held low until the clock oscillation settles (at least 8 ms—the oscillation settling time—when using a crystal oscillator). When the $\overline{\text{RES}}$ pin is subsequently driven high, a transition is made to the program execution state via the reset exception handling state.

24.7.2 Hardware Standby Mode Timing

Figure 24.4 shows an example of hardware standby mode timing.

When the $\overline{\text{STBY}}$ pin is driven low after the $\overline{\text{RES}}$ pin has been driven low, a transition is made to hardware standby mode. Hardware standby mode is cleared by driving the $\overline{\text{STBY}}$ pin high, waiting for the oscillation settling time, then changing the $\overline{\text{RES}}$ pin from low to high.

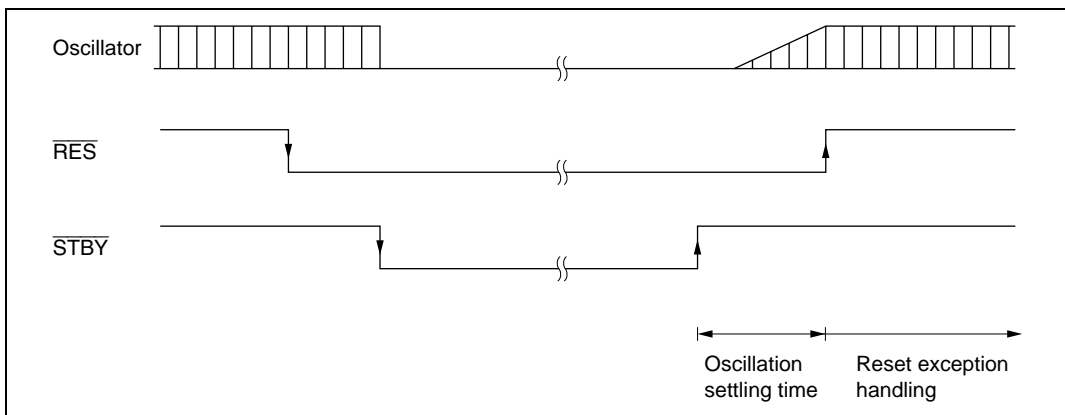


Figure 24.4 Hardware Standby Mode Timing

24.8 Watch Mode

24.8.1 Watch Mode

If a SLEEP instruction is executed in high-speed mode or subactive mode when the SSBY in SBYCR is set to 1, the DTON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT1) is set to 1, the CPU makes a transition to watch mode.

In this mode, the CPU and all on-chip supporting modules except WDT1 stop. As long as the prescribed voltage is supplied, the contents of some of the CPU's internal registers and on-chip RAM are retained, and I/O ports retain their states prior to the transition.

24.8.2 Clearing Watch Mode

Watch mode is cleared by an interrupt ($\overline{\text{WOVI1}}$ interrupt, NMI pin, or pin $\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$, $\overline{\text{IRQ2}}$, $\overline{\text{IRQ6}}$, or $\overline{\text{IRQ7}}$), or by means of the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with an Interrupt: When an interrupt request signal is input, watch mode is cleared and a transition is made to high-speed mode or medium-speed mode if the LSON bit in LPWRCR is cleared to 0, or to subactive mode if the LSON bit is set to 1. When making a transition to high-speed mode, after the elapse of the time set in bits STS2 to STS0 in SBYCR, stable clocks are supplied to the entire chip, and interrupt exception handling is started.

Watch mode cannot be cleared with an $\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$, $\overline{\text{IRQ2}}$, $\overline{\text{IRQ6}}$, or $\overline{\text{IRQ7}}$ interrupt if the corresponding enable bit has been cleared to 0, or with an on-chip supporting module interrupt if acceptance of the relevant interrupt has been disabled by the interrupt enable register or masked by the CPU.

See section 24.6.3, Setting Oscillation Settling Time after Clearing Software Standby Mode, for the oscillation settling time setting when making a transition from watch mode to high-speed mode.

Clearing with the $\overline{\text{RES}}$ Pin: See “Clearing with the $\overline{\text{RES}}$ Pin” in section 24.6.2, Clearing Software Standby Mode.

Clearing with the $\overline{\text{STBY}}$ Pin: When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

24.9 Subsleep Mode

24.9.1 Subsleep Mode

If a SLEEP instruction is executed in subactive mode when the SSBY in SBYCR is cleared to 0, the LSON bit in LPWRCCR is set to 1, and the PSS bit in TCSR (WDT1) is set to 1, the CPU makes a transition to subsleep mode.

In this mode, the CPU and all on-chip supporting modules except TMR0, TMR1, WDT0, and WDT1 stop. As long as the prescribed voltage is supplied, the contents of some of the CPU's internal registers and on-chip RAM are retained, and I/O ports retain their states prior to the transition.

24.9.2 Clearing Subsleep Mode

Subsleep mode is cleared by an interrupt (on-chip supporting module interrupt, NMI pin, or pin $\overline{\text{IRQ0}}$ to $\overline{\text{IRQ7}}$), or by means of the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with an Interrupt: When an interrupt request signal is input, subsleep mode is cleared and interrupt exception handling is started. Subsleep mode cannot be cleared with an $\overline{\text{IRQ0}}$ to $\overline{\text{IRQ7}}$ interrupt if the corresponding enable bit has been cleared to 0, or with an on-chip supporting module interrupt if acceptance of the relevant interrupt has been disabled by the interrupt enable register or masked by the CPU.

Clearing with the $\overline{\text{RES}}$ Pin: See “Clearing with the $\overline{\text{RES}}$ Pin” in section 24.6.2, Clearing Software Standby Mode.

Clearing with the $\overline{\text{STBY}}$ Pin: When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode

24.10 Subactive Mode

24.10.1 Subactive Mode

If a SLEEP instruction is executed in high-speed mode when the SSBY bit in SBYCR, the DTON bit in LPWRCR, and the PSS bit in TCSR (WDT1) are all set to 1, the CPU makes a transition to subactive mode. When an interrupt is generated in watch mode, if the LSON bit in LPWRCR is set to 1, a transition is made to subactive mode directly. When an interrupt is generated in subsleep mode, a transition is made to subactive mode.

In subactive mode, the CPU performs sequential program execution at low speed on the subclock. In this mode, all on-chip supporting modules except TMR0, TMR1, WDT0, and WDT1 stop.

When operating the device in subactive mode, bits SCK2 to SCK0 in SBYCR must all be cleared to 0.

24.10.2 Clearing Subactive Mode

Subsleep mode is cleared by a SLEEP instruction, or by means of the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with a SLEEP Instruction: When a SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1, the DTON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT1) is set to 1, subactive mode is cleared and a transition is made to watch mode. When a SLEEP instruction is executed while the SSBY bit in SBYCR is cleared to 0, the LSON bit in LPWRCR is set to 1, and the PSS bit in TCSR (WDT1) is set to 1, a transition is made to subsleep mode. When a SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1, the DTON bit is set to 1 and the LSON bit is cleared to 0 in LPWRCR, and the PSS bit in TCSR (WDT1) is set to 1, a transition is made directly to high-speed mode.

For details of direct transition, see section 24.11, Direct Transition.

Clearing with the $\overline{\text{RES}}$ Pin: See “Clearing with the $\overline{\text{RES}}$ Pin” in section 24.6.2, Clearing Software Standby Mode.

Clearing with the $\overline{\text{STBY}}$ Pin: When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode

24.11 Direct Transition

24.11.1 Overview of Direct Transition

There are three operating modes in which the CPU executes programs: high-speed mode, medium-speed mode, and subactive mode. A transition between high-speed mode and subactive mode without halting the program is called a direct transition. A direct transition can be carried out by setting the DTON bit in LPWRCR to 1 and executing a SLEEP instruction. After the transition, direct transition exception handling is started.

Direct Transition from High-Speed Mode to Subactive Mode: If a SLEEP instruction is executed in high-speed mode while the SSBY bit in SBYCR, the LSON bit and DTON bit in LPWRCR, and the PSS bit in TSCR (WDT1) are all set to 1, a transition is made to subactive mode.

Direct Transition from Subactive Mode to High-Speed Mode: If a SLEEP instruction is executed in subactive mode while the SSBY bit in SBYCR is set to 1, the LSON bit is cleared to 0 and the DTON bit is set to 1 in LPWRCR, and the PSS bit in TSCR (WDT1) is set to 1, after the elapse of the time set in bits STS2 to STS0 in SBYCR, a transition is made to directly to high-speed mode.

24.12 Usage Notes

1. When making a transition to subactive mode or watch mode, set the DTC to enter module stop mode (write 1 to the relevant bits in MSTPCR), and then read the relevant bits to confirm that they are set to 1 before mode transition. Do not clear module stop mode (write 0 to the relevant bits in MSTPCR) until a transition from subactive mode to high-speed mode or medium-speed mode has been performed.

If a DTC activation source occurs in sub-active mode, the DTC will be activated only after module stop mode has been cleared and high-speed mode or medium-speed mode has been entered.

2. The on-chip peripheral modules (DTC and TPU) which halt operation in subactive mode cannot clear an interrupt in subactive mode. Therefore, if a transition is made to sub-active mode while an interrupt is requested, the CPU interrupt source cannot be cleared. Disable the interrupts of each on-chip peripheral module before executing a SLEEP instruction to enter subactive mode or watch mode.

Section 25 Electrical Characteristics

25.1 Voltage of Power Supply and Operating Range

The power supply voltage and operating range (shaded part) for each product are shown in table 25.1.

Table 25.1 Power Supply Voltage and Operating Range (1) (F-ZTAT Products)

| Product/ Power supply | 5-V version | Product/ Power supply | 3-V version |
|--------------------------------------|--|---|---|
| HD64F2138 HD64F2134 HD64F2132R | | HD64F2138V HD64F2134V HD64F2132RV | |
| VCC1 pin VCC2 pin | $V_{cc} = 5.0\text{ V} \pm 10\%$ (fop = 2 to 20 MHz) $V_{cc} = 4.0\text{ V to } 5.5\text{ V}$ (fop = 2 to 16 MHz) | VCC1 pin VCC2 pin | $V_{cc} = 3.0\text{ V to } 5.5\text{ V}$ (fop = 2 to 10 MHz) |
| AVCC pin | $AV_{cc} = 5.0\text{ V} \pm 10\%$ (fop = 2 to 20 MHz) $AV_{cc} = 4.0\text{ V to } 5.5\text{ V}$ (fop = 2 to 16 MHz) | AVCC pin | $AV_{cc} = 3.0\text{ V to } 5.5\text{ V}$ (fop = 2 to 10 MHz) |

Table 25.1 Power Supply Voltage and Operating Range (2) (F-ZTAT A-Mask Products)

| Product/ Power supply | 5-V version | Product/ Power supply | 3-V version |
|--------------------------|---|----------------------------|---|
| HD64F2138A HD64F2134A | | HD64F2138AV HD64F2134AV | |
| VCC1 pin | $V_{cc} = 5.0 \text{ V} \pm 10\%$ (fop = 2 to 20 MHz) $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ (fop = 2 to 16 MHz) | VCC1 pin | $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ (fop = 2 to 10 MHz) (CIN in use $V_{cc} = 3.0 \text{ V to } 3.6 \text{ V}$) |
| VCL pin (VCC2) | $V_{cl} = \text{C connect}$ | VCL pin (VCC2) | $V_{cl} = V_{cc} \text{ connect}$ |
| AVCC pin | $AV_{cc} = 5.0 \text{ V} \pm 10\%$ (fop = 2 to 20 MHz) $AV_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ (fop = 2 to 16 MHz) | AVCC pin | $AV_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ (fop = 2 to 10 MHz) (CIN in use $AV_{cc} = 3.0 \text{ V to } 3.6 \text{ V}$) |

Table 25.1 Power Supply Voltage and Operating Range (3) (Mask-ROM Products)

| Product/ Power supply | 5-V version | 4-V version | 3-V version |
|--|------------------------------------|---|--|
| HD6432138S HD6432138SW HD6432137S HD6432137SW HD6432134S HD6432133S | | | |
| VCC1 pin | $V_{cc} = 5.0 \text{ V} \pm 10\%$ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ (CIN in use $V_{cc} = 3.0 \text{ V to } 3.6 \text{ V}$) |
| VCL pin (VCC2) | $V_{cl} = \text{C connect}$ | $V_{cl} = \text{C connect}$ | $V_{cl} = V_{cc} \text{ connect}$ |
| AVCC pin | $AV_{cc} = 5.0 \text{ V} \pm 10\%$ | $AV_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | $AV_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ (CIN in use $AV_{cc} = 3.0 \text{ V to } 3.6 \text{ V}$) |

Table 25.1 Power Supply Voltage and Operating Range (4) (Mask-ROM Products)

| Product/ Power supply | 5-V version | 4-V version | 3-V version |
|--------------------------|--|--|--|
| HD6432132 HD6432130 | <p>A graph showing the operating range for the 5-V version. The vertical axis is labeled V_{cc} and has tick marks at 4.5 V and 5.5 V. The horizontal axis is labeled f_{op} and has tick marks at 2 MHz and 20 MHz. A shaded rectangular area represents the operating range, extending from 4.5 V to 5.5 V on the vertical axis and from 2 MHz to 20 MHz on the horizontal axis.</p> | <p>A graph showing the operating range for the 4-V version. The vertical axis is labeled V_{cc} and has tick marks at 4.0 V and 5.5 V. The horizontal axis is labeled f_{op} and has tick marks at 2 MHz and 16 MHz. A shaded rectangular area represents the operating range, extending from 4.0 V to 5.5 V on the vertical axis and from 2 MHz to 16 MHz on the horizontal axis.</p> | <p>A graph showing the operating range for the 3-V version. The vertical axis is labeled V_{cc} and has tick marks at 2.7 V and 5.5 V. The horizontal axis is labeled f_{op} and has tick marks at 2 MHz and 10 MHz. A shaded rectangular area represents the operating range, extending from 2.7 V to 5.5 V on the vertical axis and from 2 MHz to 10 MHz on the horizontal axis.</p> |
| VCC1 pin VCC2 pin | $V_{cc} = 5.0 \text{ V} \pm 10\%$ | $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | $V_{cc} = 2.7 \text{ V to } 5.5 \text{ V}$ |
| AVCC pin | $AV_{cc} = 5.0 \text{ V} \pm 10\%$ | $AV_{cc} = 4.0 \text{ V to } 5.5 \text{ V}$ | $AV_{cc} = 2.7 \text{ V to } 5.5 \text{ V}$ |

25.2 Electrical Characteristics of H8S/2138 F-ZTAT

25.2.1 Absolute Maximum Ratings

Table 25.2 lists the absolute maximum ratings.

Table 25.2 Absolute Maximum Ratings

| Item | Symbol | Value | Unit |
|--|-----------|---|------|
| Power supply voltage* | V_{CC} | -0.3 to +7.0 | V |
| Input voltage (except ports 6 and 7) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input not selected for port 6) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input selected for port 6) | V_{in} | Lower voltage of -0.3 to $V_{CC} + 0.3$ and $AV_{CC} + 0.3$ | V |
| Input voltage (port 7) | V_{in} | -0.3 to $AV_{CC} + 0.3$ | V |
| Analog power supply voltage | AV_{CC} | -0.3 to +7.0 | V |
| Analog input voltage | V_{AN} | -0.3 to $AV_{CC} + 0.3$ | V |
| Operating temperature | T_{opr} | Regular specifications: -20 to +75 | °C |
| | | Wide-range specifications: -40 to +85 | °C |
| Operating temperature (flash memory programming/erasing) | T_{opr} | Regular specifications: 0 to +75 | °C |
| | | Wide-range specifications: 0 to +85 | °C |
| Storage temperature | T_{stg} | -55 to +125 | °C |

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

* Voltage applied to the VCC1 and VCC2 pins.

25.2.2 DC Characteristics

Table 25.3 lists the DC characteristics. Table 25.4 lists the permissible output currents.

Table 25.3 DC Characteristics (1)

Conditions: $V_{CC} = 5.0\text{ V} \pm 10\%$, $AV_{CC}^{*1} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}^{*9}$ (regular specifications), $T_a = -40\text{ to }+85^\circ\text{C}^{*9}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|--|---|--|----------------------|-----|---------------------|------|-----------------|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *6} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | (1) V_T^- | 1.0 | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | |
| Schmitt trigger input voltage (in level switching) ^{*6} | P67 to P60 (KWUL = 01) | V_T^- | $V_{CC} \times 0.3$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| | P67 to P60 (KWUL = 10) | V_T^- | $V_{CC} \times 0.4$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.8$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.03$ | — | — | V | |
| | P67 to P60 (KWUL = 11) | V_T^- | $V_{CC} \times 0.45$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.9$ | V | |
| | | $V_T^+ - V_T^-$ | 0.05 | — | — | V | |
| Input high voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, NMI, MD1, MD0 | (2) V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | EXTAL | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | Port 7 | 2.0 | — | $AV_{CC} + 0.3$ | V | |
| | | Input pins except (1) and (2) above | 2.0 | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, MD1, MD0 | (3) V_{IL} | -0.3 | — | 0.5 | V | |
| | | NMI, EXTAL, input pins except (1) and (3) above | -0.3 | — | 0.8 | V | |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|--|--------------|----------------|------|------|--------------------------|---|
| Output high voltage | All output pins (except P97, and P52 ^{*4})*5 | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$ |
| | P97, P52 ^{*4} | 2.5 | — | — | V | $I_{OH} = -1 \text{ mA}$ | |
| Output low voltage | All output pins ^{*5} | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6 \text{ mA}$ |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 10 \text{ mA}$ |
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ |
| Input pull-up MOS current | Ports 1 to 3 | $-I_p$ | 50 | — | 300 | μA | $V_{in} = 0 \text{ V}$ |
| | Port 6 (P6PUE = 0) | | 60 | — | 500 | μA | |
| | Port 6 (P6PUE = 1) | | 15 | — | 150 | μA | |
| Input capacitance | \overline{RES} | (4) C_{in} | — | — | 80 | pF | $V_{in} = 0 \text{ V}$, $f = 1 \text{ MHz}$, $T_a = 25^\circ C$ |
| | NMI | | — | — | 50 | pF | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | |
| | Input pins except (4) above | | — | — | 15 | pF | |
| Current dissipation ^{*7} | Normal operation | I_{CC} | — | 85 | 120 | mA | $f = 20 \text{ MHz}$ |
| | Sleep mode | | — | 70 | 100 | mA | $f = 20 \text{ MHz}$ |
| | Standby mode ^{*8} | | — | 0.01 | 5.0 | μA | $T_a \leq 50^\circ C$ |
| | | | — | — | 20.0 | μA | $50^\circ C < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0 \text{ V to } 5.5 \text{ V}$ |

| Item | Symbol | Min | Typ | Max | Test | |
|-------------------------------|------------------|-----|-----|-----|------|---------------|
| | | | | | Unit | Conditions |
| Analog power supply voltage*1 | AV _{CC} | 4.5 | — | 5.5 | V | Operating |
| | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | V _{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{CC}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.
4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138.
An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1).
P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138.
5. When ICE = 0. Low-level output when the bus drive function is selected is determined separately.
6. The upper limit of the port 6 applied voltage is V_{CC} +0.3 V when CIN input is not selected, and the lower of V_{CC} +0.3 V and AV_{CC} +0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
7. Current dissipation values are for V_{IH} min = V_{CC} -0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
8. The values are for V_{RAM} ≤ V_{CC} < 4.5V, V_{IH} min = V_{CC} × 0.9, and V_{IL} max = 0.3 V.
9. For flash memory program/erase operations, the applicable range is T_a = 0 to +75°C (regular specifications) or T_a = 0 to +85°C (wide-range specifications).

Table 25.3 DC Characteristics (2)

Conditions: $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}^{*7}$, $AV_{CC}^{*1} = 4.0 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^\circ\text{C}^{*7}$ (regular specifications), $T_a = -40 \text{ to } +85^\circ\text{C}^{*7}$ (wide-range specifications)

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|--|---|----------------------|----------------------|---------------------|---------------------|-----------------|--|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *6} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | V_T^- | 1.0 | — | — | V | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | |
| | | V_T^- | 0.8 | — | — | V | $V_{CC} < 4.5 \text{ V}$ |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.3 | — | — | V | |
| Schmitt trigger input voltage (in level switching) ^{*6} | P67 to P60 (KWUL = 01) | V_T^- | $V_{CC} \times 0.3$ | — | — | V | $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}$ |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| | P67 to P60 (KWUL = 10) | V_T^- | $V_{CC} \times 0.4$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.8$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.03$ | — | — | V | |
| P67 to P60 (KWUL = 11) | V_T^- | $V_{CC} \times 0.45$ | — | — | V | | |
| | V_T^+ | — | — | $V_{CC} \times 0.9$ | V | | |
| | $V_T^+ - V_T^-$ | 0.05 | — | — | V | | |
| | | | | | | | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 | V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | EXTAL | 2.0 | — | $AV_{CC} + 0.3$ | V | | |
| | Port 7 | 2.0 | — | $V_{CC} + 0.3$ | V | | |
| | Input pins except (1) and (2) above | | 2.0 | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | RES, STBY, MD1, MD0 | V_{IL} | -0.3 | — | 0.5 | V | |
| | NMI, EXTAL, input pins except (1) and (3) above | | -0.3 | — | 0.8 | V | |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|---|---|-------------|----------------|------|------|---------|--|--|
| Output high voltage | All output pins (except P97, and P52*4)*5 | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | |
| | | | 3.0 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} < 4.5 \text{ V}$ | |
| | P97, P52*4 | | 2.0 | — | — | V | $I_{OH} = -1 \text{ mA}$ | |
| Output low voltage | All output pins*5 | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6 \text{ mA}$ | |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 10 \text{ mA}$ | |
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ | |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | | |
| | Port 7 | | — | — | 1.0 | μA | | $V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ | |
| Input pull-up MOS current | Ports 1 to 3 | $-I_p$ | 50 | — | 300 | μA | $V_{in} = 0 \text{ V}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | |
| | Port 6 (P6PUE = 0) | | 60 | — | 500 | μA | | |
| | Port 6 (P6PUE = 1) | | 15 | — | 150 | μA | | |
| | Ports 1 to 3 | | 30 | — | 200 | μA | | $V_{in} = 0 \text{ V}$, $V_{CC} < 4.5 \text{ V}$ |
| | Port 6 (P6PUE = 0) | | 40 | — | 400 | μA | | |
| | Port 6 (P6PUE = 1) | | 10 | — | 110 | μA | | |
| Input capacitance | \overline{RES} (4) | C_{in} | — | — | 80 | pF | $V_{in} = 0 \text{ V}$, $f = 1 \text{ MHz}$, $T_a = 25^\circ C$ | |
| | NMI | | — | — | 50 | pF | | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | | |
| | Input pins except (4) above | | — | — | 15 | pF | | |
| Current dissipation*8 | Normal operation | I_{CC} | — | 70 | 100 | mA | $f = 16 \text{ MHz}$ | |
| | Sleep mode | | — | 60 | 85 | mA | $f = 16 \text{ MHz}$ | |
| | Standby mode*9 | | — | 0.01 | 5.0 | μA | $T_a \leq 50^\circ C$ | |
| | | | — | — | 20.0 | μA | $50^\circ C < T_a$ | |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|----------------------------|-----------|-----|------|-----|---------|---|
| Analog power supply current | During A/D, D/A conversion | I_{CC} | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μ A | $AV_{CC} = 2.0 \text{ V to } 5.5 \text{ V}$ |
| Analog power supply voltage ^{*1} | | AV_{CC} | 4.0 | — | 5.5 | V | Operating |
| | | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | |

- Notes: 1. Do not leave the AV_{CC} , and AV_{SS} pins open even if the A/D converter and D/A converter are not used.
Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AV_{CC} by connection to the power supply (V_{CC}), or some other method.
2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. $\overline{IRQ2}$ includes the \overline{ADTRG} signal multiplexed on that pin.
4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138.
An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 ($ICE = 1$).
P52/SCK0 and P97 ($ICE = 0$) high levels are driven by NMOS in H8S/2138.
5. When $ICE = 0$. Low-level output when the bus drive function is selected is determined separately.
6. The upper limit of the port 6 applied voltage is $V_{CC} + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{CC} + 0.3 \text{ V}$ and $AV_{CC} + 0.3 \text{ V}$ when CIN input is selected.
When a pin is in output mode, the output voltage is equivalent to the applied voltage.
7. Ranges of $V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$, $T_a = 0 \text{ to } +75^\circ\text{C}$ (regular specifications), and $T_a = 0 \text{ to } +85^\circ\text{C}$ (wide-range specifications) must be observed for flash memory programming/erasing.
8. Current dissipation values are for $V_{IH} \text{ min} = V_{CC} - 0.5 \text{ V}$ and $V_{IL} \text{ max} = 0.5 \text{ V}$ with all output pins unloaded and the on-chip pull-up MOSs in the off state.
9. The values are for $V_{RAM} \leq V_{CC} < 4.0 \text{ V}$, $V_{IH} \text{ min} = V_{CC} \times 0.9$, and $V_{IL} \text{ max} = 0.3 \text{ V}$.

Table 25.3 DC Characteristics (3)

Conditions: $V_{CC} = 3.0\text{ V to }5.5\text{ V}^{*7}$, $AV_{CC}^{*1} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$,
 $T_a = -20\text{ to }+75^\circ\text{C}^{*7}$

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|--|---|----------------------|----------------------|---------------------|---------------------|-----------------|--|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *6} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | (1) V_T^- | $V_{CC} \times 0.2$ | — | — | V | |
| | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | | |
| | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | | |
| Schmitt trigger input voltage (in level switching) | P67 to P60 (KWUL = 01) | V_T^- | $V_{CC} \times 0.3$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| | P67 to P60 (KWUL = 10) | V_T^- | $V_{CC} \times 0.4$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.8$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.03$ | — | — | V | |
| P67 to P60 (KWUL = 11) | V_T^- | $V_{CC} \times 0.45$ | — | — | V | | |
| | V_T^+ | — | — | $V_{CC} \times 0.9$ | V | | |
| | $V_T^+ - V_T^-$ | 0.05 | — | — | V | | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 | (2) V_{IH} | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | EXTAL | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | Port 7 | | $V_{CC} \times 0.7$ | — | $AV_{CC} + 0.3$ | V | |
| | Input pins except (1) and (2) above | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | RES, STBY, MD1, MD0 | (3) V_{IL} | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | NMI, EXTAL, input pins except (1) and (3) above | | -0.3 | — | $V_{CC} \times 0.2$ | V | |
| Output high voltage | All output pins (except P97, and P52 ^{*4})*5 | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200\ \mu\text{A}$ |
| | | V_{OH} | $V_{CC} - 1.0$ | — | — | V | $I_{OH} = -1\ \text{mA}$ ($V_{CC} < 4.0\ \text{V}$) |
| | P97, P52 ^{*4} | V_{OH} | 1.0 | — | — | V | $I_{OH} = -1\ \text{mA}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|--|--------------|-----|------|------|---------------|--|
| Output low voltage | All output pins ^{*5} | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6\text{mA}$ |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 5\text{mA}$ ($V_{CC} < 4.0\text{V}$), $I_{OL} = 10\text{mA}$ ($4.0\text{V} \leq V_{CC} \leq 5.5\text{V}$) |
| Input leakage current | $\overline{\text{RES}}$ | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{V}$ |
| | $\overline{\text{STBY}}$, NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }AV_{CC} - 0.5\text{V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{V}$ |
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 10 | — | 150 | μA | $V_{in} = 0\text{V}$, $V_{CC} = 3.0\text{V to }3.6\text{V}$ |
| | Port 6 (P6PUE = 0) | | 30 | — | 250 | μA | |
| | Port 6 (P6PUE = 1) | | 3 | — | 70 | μA | |
| Input capacitance | $\overline{\text{RES}}$ | (4) C_{in} | — | — | 80 | pF | $V_{in} = 0\text{V}$, $f = 1\text{MHz}$, $T_a = 25^\circ\text{C}$ |
| | NMI | | — | — | 50 | pF | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | |
| | Input pins except (4) above | | — | — | 15 | pF | |
| Current dissipation ^{*8} | Normal operation | I_{CC} | — | 50 | 70 | mA | $f = 10\text{MHz}$ |
| | Sleep mode | | — | 40 | 60 | mA | $f = 10\text{MHz}$ |
| | Standby mode ^{*9} | | — | 0.01 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0\text{V to }5.5\text{V}$ |

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|-------------------------------|------------------|-----|-----|-----|------|-----------------|
| Analog power supply voltage*1 | AV _{CC} | 3.0 | — | 5.5 | V | Operating |
| | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | V _{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{CC}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. IRQ2 includes the ADTRG signal multiplexed on that pin.
4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138.
An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1).
P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138.
5. When ICE = 0. Low-level output when the bus drive function is selected is determined separately.
6. The upper limit of the port 6 applied voltage is V_{CC} +0.3 V when CIN input is not selected, and the lower of V_{CC} +0.3 V and AV_{CC} +0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
7. For flash memory program/erase operations, the applicable ranges are V_{CC} = 3.0 V to 3.6 V, T_a = 0 to +75°C.
8. Current dissipation values are for V_{IH} min = V_{CC} -0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
9. The values are for V_{RAM} ≤ V_{CC} < 3.0 V, V_{IH} min = V_{CC} × 0.9, and V_{IL} max = 0.3 V.

Table 25.4 Permissible Output Currents

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications),
 $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0 | I_{OL} | — | — | 20 | mA |
| | Ports 1 to 3 | | — | — | 10 | mA |
| | Other output pins | | — | — | 2 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 80 | mA |
| | Total of all output pins, including the above | | — | — | 120 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| | Total of all output pins | $\sum -I_{OH}$ | — | — | 40 | mA |

Conditions: $V_{CC} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0 | I_{OL} | — | — | 10 | mA |
| | Ports 1 to 3 | | — | — | 2 | mA |
| | Other output pins | | — | — | 1 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 40 | mA |
| | Total of all output pins, including the above | | — | — | 60 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| | Total of all output pins | $\sum -I_{OH}$ | — | — | 30 | mA |

Notes: 1. To protect chip reliability, do not exceed the output current values in table 25.3.

2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 25.1 and 25.2.

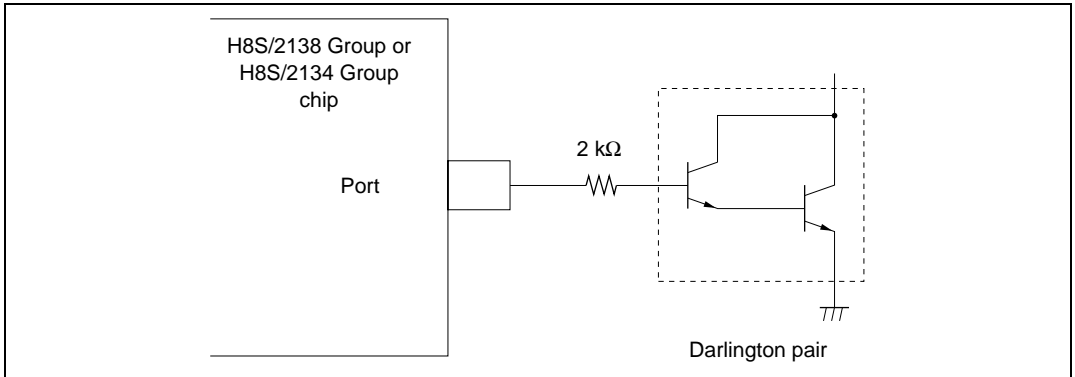


Figure 25.1 Darlington Pair Drive Circuit (Example)

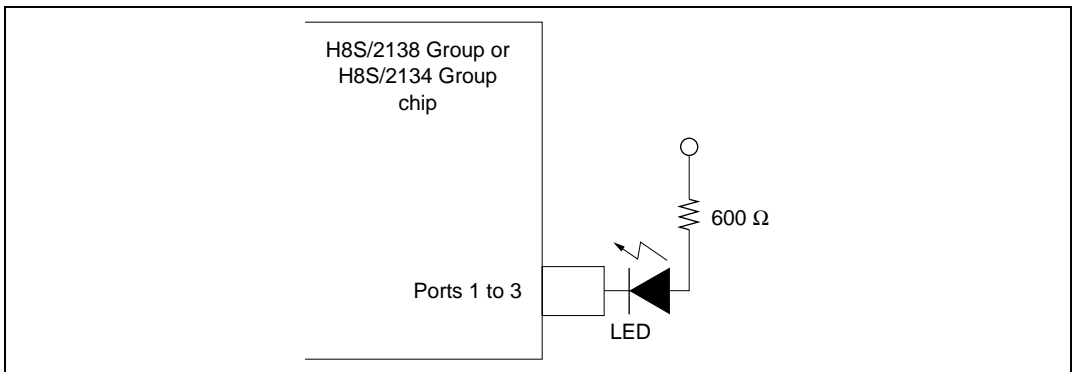


Figure 25.2 LED Drive Circuit (Example)

Table 25.5 Bus Drive CharacteristicsConditions: $V_{CC} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$

Applicable Pins: SCL1, SCL0, SDA1, SDA0 (bus drive function selected)

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|-----------------|----------------------|-----|---------------------|---------------|--|
| Schmitt trigger input voltage | V_T^- | $V_{CC} \times 0.3$ | — | — | V | $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ |
| | V_T^+ | — | — | $V_{CC} \times 0.7$ | | $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ |
| | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | | $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ |
| Input high voltage | V_{IH} | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.5$ | V | $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ |
| Input low voltage | V_{IL} | -0.5 | — | $V_{CC} \times 0.3$ | | $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ |
| Output low voltage | V_{OL} | — | — | 0.8 | V | $I_{OL} = 16\text{ mA}$, $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ |
| | | | | 0.5 | | $I_{OL} = 8\text{ mA}$ |
| | | | | 0.4 | | $I_{OL} = 3\text{ mA}$ |
| Input capacitance | C_{in} | — | — | 20 | pF | $V_{in} = 0\text{ V}$, $f = 1\text{ MHz}$, $T_a = 25^\circ\text{C}$ |
| Three-state leakage current (off state) | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |
| SCL, SDA output fall time | t_{of} | $20 + 0.1Cb$ | — | 250 | ns | $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ |

25.2.3 AC Characteristics

Clock timing, control signal timing, bus timing, and timing of on-chip supporting modules list the following.

Figure 25.4 shows the test conditions for the AC characteristics.

(1) Clock Timing

Table 25.6 shows the clock timing. The clock timing specified here covers clock (ϕ) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details of external clock input (EXTAL pin and EXCL pin) timing, see section 23, Clock Pulse Generator.

Table 25.6 Clock Timing

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0 \text{ V}$ to 5.5 V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|---|------------|-------------|-----|-------------|-----|-------------|-----|---------------|----------------------------|
| | | 20 MHz | Max | 16 MHz | Max | 10 MHz | Max | | |
| Clock cycle time | t_{cyc} | 50 | 500 | 62.5 | 500 | 100 | 500 | ns | Figure 25.5 |
| Clock high pulse width | t_{CH} | 17 | — | 20 | — | 30 | — | ns | |
| Clock low pulse width | t_{CL} | 17 | — | 20 | — | 30 | — | ns | |
| Clock rise time | t_{Cr} | — | 8 | — | 10 | — | 20 | ns | |
| Clock fall time | t_{Cf} | — | 8 | — | 10 | — | 20 | ns | |
| Oscillation settling time at reset (crystal) | t_{OSC1} | 10 | — | 10 | — | 20 | — | ms | Figure 25.6 Figure 25.7 |
| Oscillation settling time in software standby (crystal) | t_{OSC2} | 8 | — | 8 | — | 8 | — | ms | |
| External clock output stabilization delay time | t_{DEXT} | 500 | — | 500 | — | 500 | — | μs | |

(2) Control Signal Timing

Table 25.7 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768$ kHz) are NMI and IRQ0, IRQ1, IRQ2, IRQ6, and IRQ7.

Table 25.7 Control Signal Timing

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|--|-------------------|-------------|-----|-------------|-----|-------------|-----|------------------|-----------------|
| | | Min | Max | Min | Max | Min | Max | | |
| $\overline{\text{RES}}$ setup time | t_{RESS} | 200 | — | 200 | — | 300 | — | ns | Figure 25.8 |
| $\overline{\text{RES}}$ pulse width | t_{RESW} | 20 | — | 20 | — | 20 | — | t_{cyc} | |
| NMI setup time (NMI) | t_{NMIS} | 150 | — | 150 | — | 250 | — | ns | Figure 25.9 |
| NMI hold time (NMI) | t_{NMIH} | 10 | — | 10 | — | 10 | — | | |
| NMI pulse width (exiting software standby mode) | t_{NMIW} | 200 | — | 200 | — | 200 | — | ns | |
| IRQ setup time (IRQ7 to IRQ0) | t_{IRQS} | 150 | — | 150 | — | 250 | — | ns | |
| IRQ hold time (IRQ7 to IRQ0) | t_{IRQH} | 10 | — | 10 | — | 10 | — | ns | |
| IRQ pulse width (IRQ7, IRQ6, IRQ2 to IRQ0) (exiting software standby mode) | t_{IRQW} | 200 | — | 200 | — | 200 | — | ns | |

(3) Bus Timing

Table 25.8 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768$ kHz).

Table 25.8 Bus Timing

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|----------------------------------|------------|---------------------------|-----|---------------------------|-----|---------------------------|-----|------|------------------------------|
| | | 20 MHz | Max | 16 MHz | Max | 10 MHz | Max | | |
| Address delay time | t_{AD} | — | 20 | — | 30 | — | 40 | ns | Figure 25.10 to figure 25.14 |
| Address setup time | t_{AS} | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | $0.5 \times t_{cyc} - 30$ | — | ns | |
| Address hold time | t_{AH} | $0.5 \times t_{cyc} - 10$ | — | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | ns | |
| \overline{CS} delay time (IOS) | t_{CSD} | — | 20 | — | 30 | — | 40 | ns | |
| \overline{AS} delay time | t_{ASD} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 1 | t_{RSD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 2 | t_{RSD2} | — | 30 | — | 45 | — | 60 | ns | |
| Read data setup time | t_{RDS} | 15 | — | 20 | — | 35 | — | ns | |
| Read data hold time | t_{RDH} | 0 | — | 0 | — | 0 | — | ns | |

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|-------------------------------|------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|------|------------------------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| Read data access time 1 | t_{ACC1} | — | $1.0 \times t_{cyc} - 30$ | — | $1.0 \times t_{cyc} - 40$ | — | $1.0 \times t_{cyc} - 60$ | ns | Figure 25.10 to figure 25.14 |
| Read data access time 2 | t_{ACC2} | — | $1.5 \times t_{cyc} - 25$ | — | $1.5 \times t_{cyc} - 35$ | — | $1.5 \times t_{cyc} - 50$ | ns | |
| Read data access time 3 | t_{ACC3} | — | $2.0 \times t_{cyc} - 30$ | — | $2.0 \times t_{cyc} - 40$ | — | $2.0 \times t_{cyc} - 60$ | ns | |
| Read data access time 4 | t_{ACC4} | — | $2.5 \times t_{cyc} - 25$ | — | $2.5 \times t_{cyc} - 35$ | — | $2.5 \times t_{cyc} - 50$ | ns | |
| Read data access time 5 | t_{ACC5} | — | $3.0 \times t_{cyc} - 30$ | — | $3.0 \times t_{cyc} - 40$ | — | $3.0 \times t_{cyc} - 60$ | ns | |
| \overline{WR} delay time 1 | t_{WRD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} delay time 2 | t_{WRD2} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} pulse width 1 | t_{WSW1} | $1.0 \times t_{cyc} - 20$ | — | $1.0 \times t_{cyc} - 30$ | — | $1.0 \times t_{cyc} - 40$ | — | ns | |
| \overline{WR} pulse width 2 | t_{WSW2} | $1.5 \times t_{cyc} - 20$ | — | $1.5 \times t_{cyc} - 30$ | — | $1.5 \times t_{cyc} - 40$ | — | ns | |
| Write data delay time | t_{WDD} | — | 30 | — | 45 | — | 60 | ns | |
| Write data setup time | t_{WDS} | 0 | — | 0 | — | 0 | — | ns | |
| Write data hold time | t_{WDH} | 10 | — | 15 | — | 20 | — | ns | |
| \overline{WAIT} setup time | t_{WTS} | 30 | — | 45 | — | 60 | — | ns | |
| \overline{WAIT} hold time | t_{WTH} | 5 | — | 5 | — | 10 | — | ns | |

(4) Timing of On-Chip Supporting Modules

Tables 25.9 and 25.10 show the on-chip supporting module timing. The only on-chip supporting modules that can operate in subclock operation ($\phi = 32.768$ kHz) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 25.9 Timing of On-Chip Supporting Modules (1)

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 32.768$ kHz*, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz*, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz*, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|-----------|------------------------------|----------------------------|-----|-------------|-----|-------------|-----|------|-----------------|--------------|
| | | Min | Max | Min | Max | Min | Max | | | |
| I/O ports | Output data delay time | t_{PVD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.15 |
| | Input data setup time | t_{PRS} | 30 | — | 30 | — | 50 | — | | |
| | Input data hold time | t_{PRH} | 30 | — | 30 | — | 50 | — | | |
| FRT | Timer output delay time | t_{FTOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.16 |
| | Timer input setup time | t_{FTIS} | 30 | — | 30 | — | 50 | — | | |
| | Timer clock input setup time | t_{FTCS} | 30 | — | 30 | — | 50 | — | | Figure 25.17 |
| | Timer clock pulse width | Single edge t_{FTCWH} | 1.5 | — | 1.5 | — | 1.5 | — | t_{cyc} | |
| | Both edges t_{FTCWL} | 2.5 | — | 2.5 | — | 2.5 | — | | | |

| Item | | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|---------------|--|---|-------------|-----|-------------|-----|-------------|-----|------------|-----------------|--------------|
| | | | 20 MHz | | 16 MHz | | 10 MHz | | | | |
| | | | Min | Max | Min | Max | Min | Max | | | |
| TMR | Timer output delay time | t_{TMOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.18 | |
| | Timer reset input setup time | t_{TMRS} | 30 | — | 30 | — | 50 | — | | Figure 25.20 | |
| | Timer clock input setup time | t_{TMCS} | 30 | — | 30 | — | 50 | — | | Figure 25.19 | |
| | Timer clock pulse width | Single edge t_{TMCWH} Both edges t_{TMCWL} | 1.5 | — | 1.5 | — | 1.5 | — | t_{cyc} | | |
| PWM, PWMX | Pulse output delay time | t_{PWOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.21 | |
| SCI | Input clock cycle | Asynchronous | t_{SCYC} | 4 | — | 4 | — | 4 | — | t_{cyc} | Figure 25.22 |
| | | Synchronous | | 6 | — | 6 | — | 6 | — | | |
| | Input clock pulse width | t_{SCKW} | 0.4 | 0.6 | 0.4 | 0.6 | 0.4 | 0.6 | t_{SCYC} | | |
| | Input clock rise time | t_{SCKr} | — | 1.5 | — | 1.5 | — | 1.5 | t_{cyc} | | |
| | Input clock fall time | t_{SCKf} | — | 1.5 | — | 1.5 | — | 1.5 | | | |
| | Transmit data delay time (synchronous) | t_{TXD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.23 | |
| | Receive data setup time (synchronous) | t_{RXS} | 50 | — | 50 | — | 100 | — | ns | | |
| | Receive data hold time (synchronous) | t_{RXH} | 50 | — | 50 | — | 100 | — | ns | | |
| A/D converter | Trigger input setup time | t_{TRGS} | 30 | — | 30 | — | 50 | — | ns | Figure 25.24 | |

Note: * Only supporting modules that can be used in subclock operation.

Table 25.9 Timing of On-Chip Supporting Modules (2)

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|-----------------|---|------------------------|------------------|-------------|-----|-------------|-----|------|-----------------|--------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | | |
| | | Min | Max | Min | Max | Min | Max | | | |
| HIF read cycle | $\overline{\text{CS}}/\text{HA0}$ setup item | t_{HAR} | 10 | — | 10 | — | 10 | — | ns | Figure 25.25 |
| | $\overline{\text{CS}}/\text{HA0}$ hold time | t_{HRA} | 10 | — | 10 | — | 10 | — | ns | |
| | $\overline{\text{IO}}\overline{\text{R}}$ pulse width | t_{HRPW} | 120 | — | 120 | — | 220 | — | ns | |
| | HDB delay time | t_{HRD} | — | 100 | — | 100 | — | 200 | ns | |
| | HDB hold time | t_{HRF} | 0 | 25 | 0 | 25 | 0 | 40 | ns | |
| | HIRQ delay time | t_{HIRQ} | — | 120 | — | 120 | — | 200 | ns | |
| HIF write cycle | $\overline{\text{CS}}/\text{HA0}$ setup item | t_{HAW} | 10 | — | 10 | — | 10 | — | ns | |
| | $\overline{\text{CS}}/\text{HA0}$ hold time | t_{HWA} | 10 | — | 10 | — | 10 | — | ns | |
| | $\overline{\text{IO}}\overline{\text{W}}$ pulse width | t_{HWPW} | 60 | — | 60 | — | 100 | — | ns | |
| | HDB setup time | Fast A20 gate not used | t_{HDW} | 30 | — | 30 | — | 50 | — | ns |
| | | Fast A20 gate used | | 45 | — | 55 | — | 85 | — | ns |
| | HDB hold time | t_{HWD} | 15 | — | 15 | — | 25 | — | ns | |
| | GA20 delay time | t_{HGA} | — | 90 | — | 90 | — | 180 | ns | |

Table 25.10 I²C Bus Timing

Conditions: $V_{CC} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $\phi = 5\text{ MHz}$ to maximum operating frequency,
 $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | Symbol | Ratings | | | Unit | Test Conditions | Notes |
|---|------------|---------|-----|------|-----------|-----------------|--------------|
| | | Min | Typ | Max | | | |
| SCL clock cycle time | t_{SCL} | 12 | — | — | t_{cyc} | | Figure 25.26 |
| SCL clock high pulse width | t_{SCLH} | 3 | — | — | t_{cyc} | | |
| SCL clock low pulse width | t_{SCLL} | 5 | — | — | t_{cyc} | | |
| SCL, SDA input rise time | t_{Sr} | — | — | 7.5* | t_{cyc} | | |
| SCL, SDA input fall time | t_{Sf} | — | — | 300 | ns | | |
| SCL, SDA input spike pulse elimination time | t_{SP} | — | — | 1 | t_{cyc} | | |
| SDA input bus free time | t_{BUF} | 5 | — | — | t_{cyc} | | |
| Start condition input hold time | t_{STAH} | 3 | — | — | t_{cyc} | | |
| Retransmission start condition input setup time | t_{STAS} | 3 | — | — | t_{cyc} | | |
| Stop condition input setup time | t_{STOS} | 3 | — | — | t_{cyc} | | |
| Data input setup time | t_{SDAS} | 0.5 | — | — | t_{cyc} | | |
| Data input hold time | t_{SDAH} | 0 | — | — | ns | | |
| SCL, SDA capacitive load | C_b | — | — | 400 | pF | | |

Note: * $17.5t_{cyc}$ can be set according to the clock selected for use by the I²C module. For details, see section 16.4, Usage Notes.

25.2.4 A/D Conversion Characteristics

Tables 25.11 and 25.12 list the A/D conversion characteristics.

Table 25.11 A/D Conversion Characteristics
(AN7 to AN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0 \text{ V}$ to 5.5 V , $AV_{CC} = 3.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|-----------------------|-------------|-----|-----------------------|-------------|-----|-----------------------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time*5 | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | 10^{*3} 5^{*4} | — | — | 10^{*3} 5^{*4} | — | — | 10^{*1} 5^{*2} | k Ω |
| Nonlinearity error | — | — | ± 3.0 | — | — | ± 3.0 | — | — | ± 7.0 | LSB |
| Offset error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Full-scale error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 4.0 | — | — | ± 4.0 | — | — | ± 8.0 | LSB |

- Notes: 1. When $4.0 \text{ V} \leq AV_{CC} \leq 5.5 \text{ V}$
 2. When $3.0 \text{ V} \leq AV_{CC} < 4.0 \text{ V}$
 3. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)
 4. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)
 5. In single mode and $\phi =$ maximum operating frequency.

Table 25.12 A/D Conversion Characteristics
(CIN7 to CIN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0 \text{ V}$ to 5.5 V , $AV_{CC} = 3.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time ^{*5} | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*3}}{5^{*4}}$ | — | — | $\frac{10^{*3}}{5^{*4}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | k Ω |
| Nonlinearity error | — | — | ± 5.0 | — | — | ± 5.0 | — | — | ± 11.0 | LSB |
| Offset error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Full-scale error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 6.0 | — | — | ± 6.0 | — | — | ± 12.0 | LSB |

- Notes: 1. When $4.0 \text{ V} \leq AV_{CC} \leq 5.5 \text{ V}$
2. When $3.0 \text{ V} \leq AV_{CC} < 4.0 \text{ V}$
3. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)
4. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)
5. In single mode and $\phi =$ maximum operating frequency.

25.2.5 D/A Conversion Characteristics

Table 25.13 lists the D/A conversion characteristics.

Table 25.13 D/A Conversion Characteristics

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0 \text{ V}$ to 5.5 V , $AV_{CC} = 3.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------|-----------------------------------|-------------|-----------|-----------|-------------|-----------|-----------|-------------|-----------|-----------|---------------|
| | | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | Bits |
| Conversion time | With 20-pF load capacitance | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| Absolute accuracy | With 2-M Ω load resistance | — | ± 1.0 | ± 1.5 | — | ± 1.0 | ± 1.5 | — | ± 2.0 | ± 3.0 | LSB |
| | With 4-M Ω load resistance | — | — | ± 1.0 | — | — | ± 1.0 | — | — | ± 2.0 | |

25.2.6 Flash Memory Characteristics

Table 25.14 shows the flash memory characteristics.

Table 25.14 Flash Memory Characteristics (Programming/Erasing Operating Range)

Conditions (5-V version): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 0 \text{ to } +75^\circ\text{C}$ (regular specifications),
 $T_a = 0 \text{ to } +85^\circ\text{C}$ (wide-range specifications)

(3-V version): $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_a = 0 \text{ to } +75^\circ\text{C}$

| Item | Symbol | Min | Typ | Max | Unit | Test Condition | |
|--------------------------------------|--|---------------|-----|------|-------------|----------------|-----------------------|
| Programming time ^{*1 *2 *4} | tP | — | 10 | 200 | ms/32 bytes | | |
| Erase time ^{*1 *3 *6} | tE | — | 100 | 1200 | ms/block | | |
| Reprogramming count | N_{WEC} | — | — | 100 | Times | | |
| Programming | Wait time after SWE-bit setting ^{*1} | x | 10 | — | — | μs | |
| | Wait time after PSU-bit setting ^{*1} | y | 50 | — | — | μs | |
| | Wait time after P-bit setting ^{*1 *4} | z | 150 | — | 200 | μs | |
| | Wait time after P-bit clear ^{*1} | α | 10 | — | — | μs | |
| | Wait time after PSU-bit clear ^{*1} | β | 10 | — | — | μs | |
| | Wait time after PV-bit setting ^{*1} | γ | 4 | — | — | μs | |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs | |
| | Wait time after PV-bit clear ^{*1} | η | 4 | — | — | μs | |
| | Maximum programming count ^{*1 *4 *5} | N | — | — | 1000 | Times | $z = 200 \mu\text{s}$ |
| Erase | Wait time after SWE-bit setting ^{*1} | x | 10 | — | — | μs | |
| | Wait time after ESU-bit setting ^{*1} | y | 200 | — | — | μs | |
| | Wait time after E-bit setting ^{*1 *6} | z | 5 | — | 10 | ms | |
| | Wait time after E-bit clear ^{*1} | α | 10 | — | — | μs | |
| | Wait time after ESU-bit clear ^{*1} | β | 10 | — | — | μs | |
| | Wait time after EV-bit setting ^{*1} | γ | 20 | — | — | μs | |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs | |
| | Wait time after EV-bit clear ^{*1} | η | 5 | — | — | μs | |
| | Maximum erase count ^{*1 *6 *7} | N | — | — | 120 | Times | $z = 10 \text{ ms}$ |

Notes: 1. Set the times according to the program/erase algorithms.

2. Programming time per 32 bytes (Shows the total period for which the P-bit in the flash memory control register (FLMCR1) is set. It does not include the programming verification time.)

3. Block erase time (shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
4. Maximum programming time (tP (max))
 $tP (\max) = \text{wait time after P-bit setting (z)} \times \text{maximum programming count (N)}$
5. Number of times when the wait time after P-bit setting (z) = 200 μs .
 The number of writes should be set according to the actual set value of (z) to allow programming within the maximum programming time (tP (max)).
6. Maximum erase time (tE (max))
 $tE (\max) = \text{Wait time after E-bit setting (z)} \times \text{maximum erase count (N)}$
7. Number of times when the wait time after E-bit setting (z) = 10 ms.
 The number of erases should be set according to the actual set value of (z) to allow erasing within the maximum erase time (tE (max)).

25.2.7 Usage Note

- (1) The F-ZTAT and mask ROM versions have been confirmed as fully meeting the reference values for electrical characteristics shown in this manual. However, actual performance figures, operating margins, noise margins, and other properties may vary due to differences in the manufacturing process, on-chip ROM, layout patterns, etc.

When system evaluation testing is carried out using the F-ZTAT version, the same evaluation tests should also be conducted for the mask ROM version when changing over to that version.

- (2) On-chip power supply step-down circuit

The H8S/2138 F-ZTAT does not incorporate an internal power supply step-down circuit.

When changing over to F-ZTAT versions or mask ROM versions incorporating an internal step-down circuit, the V_{CC2} pin has the same pin location as the V_{CL} pin in a step-down circuit.

Therefore, note that the circuit patterns differ between these two types of products.

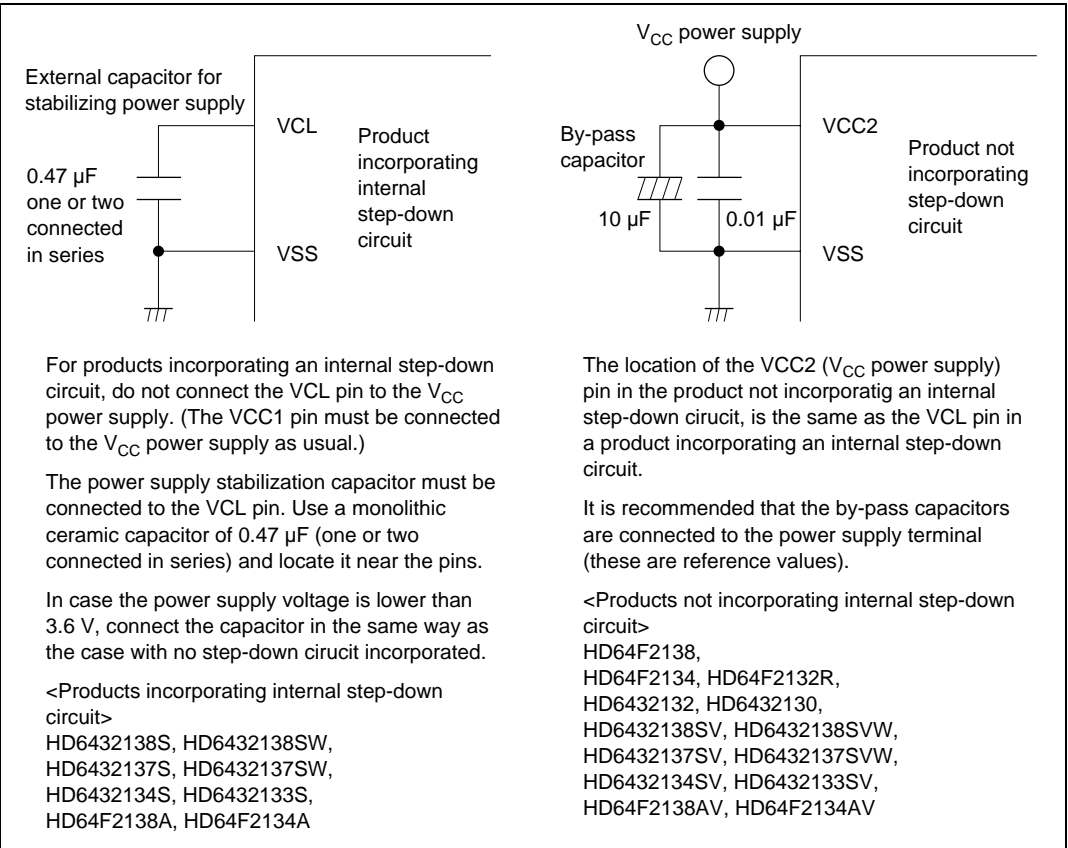


Figure 25.3 Connection of External Capacitor (Mask ROM Type Incorporating Step-Down Circuit and Product Not Incorporating Step-Down Circuit)

25.3 Electrical Characteristics of H8S/2138 F-ZTAT (A-Mask Version), and Mask ROM Versions of H8S/2138 and H8S/2137

25.3.1 Absolute Maximum Ratings

Table 25.15 lists the absolute maximum ratings.

Table 25.15 Absolute Maximum Ratings

| Item | Symbol | Value | Unit |
|--|-----------|---|------|
| Power supply voltage ^{*1} | V_{CC} | -0.3 to +7.0 | V |
| Power supply voltage ^{*1} (3-V version) | V_{CC} | -0.3 to +4.3 | V |
| Power supply voltage ^{*2} (VCL pin) | V_{CL} | -0.3 to +4.3 | V |
| Input voltage (except ports 6 and 7) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input not selected for port 6) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input selected for port 6) | V_{in} | Lower voltage of -0.3 to $V_{CC} + 0.3$ and $AV_{CC} + 0.3$ | V |
| Input voltage (port 7) | V_{in} | -0.3 to $AV_{CC} + 0.3$ | V |
| Analog power supply voltage | AV_{CC} | -0.3 to +7.0 | V |
| Analog power supply voltage (3-V version) | AV_{CC} | -0.3 to +4.3 | V |
| Analog input voltage | V_{AN} | -0.3 to $AV_{CC} + 0.3$ | V |
| Operating temperature | T_{opr} | Regular specifications: -20 to +75 | °C |
| | | Wide-range specifications: -40 to +85 | °C |
| Operating temperature (flash memory programming/erasing) | T_{opr} | Regular specifications: -20 to +75 | °C |
| | | Wide-range specifications: -40 to +85 | °C |
| Storage temperature | T_{stg} | -55 to +125 | °C |

Caution: 1. Permanent damage to the chip may result if absolute maximum ratings are exceeded.
2. Never apply more than 7.0 V to any of the pins of the 5- or 4-V version or 4.3 V to any of the pins of the 3-V version.

Notes: 1. Voltage applied to the VCC1 pin.

Never exceed the maximum rating of V_{CL} in the low-power version (3-V version) because both the VCC1 and V_{CL} pins are connected to the V_{CC} power supply.

2. It is an operating power supply voltage pin on the chip.

Never apply power supply voltage to the V_{CL} pin in the 5- or 4-V version.

Always connect an external capacitor between the V_{CL} pin and ground for internal voltage stabilization.

25.3.2 DC Characteristics

Table 25.16 lists the DC characteristics. Table 25.17 lists the permissible output currents.

Table 25.16 DC Characteristics (1)

Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC}^{*1} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS}^{*1} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^\circ\text{C}$ (regular specifications), $T_a = -40 \text{ to } +85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|--|---|--------|-----------------|----------------------|-----|---------------------|-----------------|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *6} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | (1) | V_T^- | 1.0 | — | — | V |
| | | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V |
| | | | $V_T^+ - V_T^-$ | 0.4 | — | — | V |
| Schmitt trigger input voltage (in level switching) ^{*6} | P67 to P60 (KWUL = 01) | (1) | V_T^- | $V_{CC} \times 0.3$ | — | — | V |
| | | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V |
| | | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V |
| Schmitt trigger input voltage (in level switching) ^{*6} | P67 to P60 (KWUL = 10) | (1) | V_T^- | $V_{CC} \times 0.4$ | — | — | V |
| | | | V_T^+ | — | — | $V_{CC} \times 0.8$ | V |
| | | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.03$ | — | — | V |
| | | | V_T^- | $V_{CC} \times 0.45$ | — | — | V |
| | | | V_T^+ | — | — | $V_{CC} \times 0.9$ | V |
| | | | $V_T^+ - V_T^-$ | 0.05 | — | — | V |
| Input high voltage | RES, STBY, NMI, MD1, MD0 EXTAL Port 7 Input pins except (1) and (2) above | (2) | V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V |
| | | | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V |
| | | | | 2.0 | — | $AV_{CC} + 0.3$ | V |
| | | | | 2.0 | — | $V_{CC} + 0.3$ | V |
| Input low voltage | RES, STBY, MD1, MD0 NMI, EXTAL, input pins except (1) and (3) above | (3) | V_{IL} | -0.3 | — | 0.5 | V |
| | | | | -0.3 | — | 0.8 | V |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|---|--|--------------|----------------|------|------|---|---|-----------------------|
| Output high voltage | All output pins (except P97, and P52 ^{*4} , ^{*5}) | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ | |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$ | |
| | P97, P52 ^{*4} | 2.0 | — | — | V | $I_{OH} = -200 \mu A$, $V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$ | | |
| Output low voltage | All output pins ^{*5} | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6 \text{ mA}$ | |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 10 \text{ mA}$ | |
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ | |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$ | |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSL} $ | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ | |
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 30 | — | 300 | μA | $V_{in} = 0 \text{ V}$ | |
| | Port 6 (P6PUE = 0) | | 60 | — | 600 | μA | | |
| | Port 6 (P6PUE = 1) | | 15 | — | 200 | μA | | |
| Input capacitance | \overline{RES} | (4) C_{in} | — | — | 80 | pF | $V_{in} = 0 \text{ V}$, $f = 1 \text{ MHz}$, $T_a = 25^\circ C$ | |
| | NMI | | — | — | 50 | pF | | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | | |
| | Input pins except (4) above | | — | — | 15 | pF | | |
| Current dissipation ^{*7} | Normal operation | I_{CC} | — | 55 | 70 | mA | $f = 20 \text{ MHz}$ | |
| | Sleep mode | | — | 36 | 55 | mA | $f = 20 \text{ MHz}$ | |
| | Standby mode ^{*8} | | | — | 1.0 | 5.0 | μA | $T_a \leq 50^\circ C$ |
| | | | | — | — | 20.0 | μA | $50^\circ C < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0 \text{ V to } 5.5 \text{ V}$ | |

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|------------------|-----|-----|-----|------|-----------------|
| Analog power supply voltage ^{*1} | AV _{CC} | 4.5 | — | 5.5 | V | Operating |
| | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | V _{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AV_{CC}, and AV_{SS} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AV_{CC} by connection to the power supply (V_{CC}), or some other method.

- P67 to P60 include supporting module inputs multiplexed on those pins.
- IRQ2 includes the ADTRG signal multiplexed on that pin.
- P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138.
An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1).
P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138.
- When ICE = 0. Low-level output when the bus drive function is selected is determined separately.
- The upper limit of the port 6 applied voltage is V_{CC} +0.3 V when CIN input is not selected, and the lower of V_{CC} +0.3 V and AV_{CC} +0.3 V when CIN input is selected.
When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- Current dissipation values are for V_{IH} min = V_{CC} -0.2 V and V_{IL} max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- The values are for V_{RAM} ≤ V_{CC} < 4.5V, V_{IH} min = V_{CC} -0.2 V, and V_{IL} max = 0.2 V.

Table 25.16 DC Characteristics (2)

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $AV_{CC}^{*1} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications), $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|--|---|----------------------|----------------------|---------------------|---------------------|-----------------|---|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *6} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | (1) V_T^- | 1.0 | — | — | V | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | $V_{CC} < 4.5\text{ V}$ |
| | | V_T^- | 0.8 | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.3 | — | — | V | |
| Schmitt trigger input voltage (in level switching) ^{*6} | P67 to P60 (KWUL = 01) | V_T^- | $V_{CC} \times 0.3$ | — | — | V | $V_{CC} = 4.0\text{ V to }5.5\text{ V}$ |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | P67 to P60 (KWUL = 10) | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| | | V_T^- | $V_{CC} \times 0.4$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.8$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.03$ | — | — | V | |
| P67 to P60 (KWUL = 11) | V_T^- | $V_{CC} \times 0.45$ | — | — | V | | |
| | V_T^+ | — | — | $V_{CC} \times 0.9$ | V | | |
| | $V_T^+ - V_T^-$ | 0.05 | — | — | V | | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 | (2) V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | EXTAL | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | Port 7 | 2.0 | — | $AV_{CC} + 0.3$ | V | | |
| | Input pins except (1) and (2) above | 2.0 | — | $V_{CC} + 0.3$ | V | | |
| Input low voltage | RES, STBY, MD1, MD0 | (3) V_{IL} | -0.3 | — | 0.5 | V | |
| | NMI, EXTAL, input pins except (1) and (3) above | | -0.3 | — | 0.8 | V | |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|---|--------------|----------------|-----|------|--|--|
| Output high voltage | All output pins (except P97, and P52*4)*5 | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu A$ |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | P97, P52*4 | 1.5 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} < 4.5 \text{ V}$ | |
| Output low voltage | All output pins*5 | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6 \text{ mA}$ |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 10 \text{ mA}$ |
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ |
| Input pull-up MOS current | Ports 1 to 3 | $-I_p$ | 30 | — | 300 | μA | $V_{in} = 0 \text{ V}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | Port 6 (P6PUE = 0) | | 60 | — | 600 | μA | |
| | Port 6 (P6PUE = 1) | | 15 | — | 200 | μA | |
| | Ports 1 to 3 | | 20 | — | 200 | μA | $V_{in} = 0 \text{ V}$, $V_{CC} < 4.5 \text{ V}$ |
| | Port 6 (P6PUE = 0) | | 40 | — | 500 | μA | |
| | Port 6 (P6PUE = 1) | | 10 | — | 150 | μA | |
| Input capacitance | \overline{RES} | (4) C_{in} | — | — | 80 | pF | $V_{in} = 0 \text{ V}$, $f = 1 \text{ MHz}$, $T_a = 25^\circ C$ |
| | NMI | | — | — | 50 | pF | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | |
| | Input pins except (4) above | | — | — | 15 | pF | |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|----------------------------|-----------|-----|------|------|---------------|---|
| Current dissipation* ⁷ | Normal operation | I_{CC} | — | 45 | 58 | mA | $f = 16 \text{ MHz}$ |
| | Sleep mode | | — | 30 | 46 | mA | $f = 16 \text{ MHz}$ |
| | Standby mode* ⁸ | | — | 1.0 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0 \text{ V to } 5.5 \text{ V}$ |
| Analog power supply voltage* ¹ | | AV_{CC} | 4.0 | — | 5.5 | V | Operating |
| | | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | |

- Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.
Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{CC}), or some other method.
2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. $\overline{IRQ2}$ includes the \overline{ADTRG} signal multiplexed on that pin.
4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138.
An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1).
P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138.
5. When ICE = 0. Low-level output when the bus drive function is selected is determined separately.
6. The upper limit of the port 6 applied voltage is $V_{CC} + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{CC} + 0.3 \text{ V}$ and $AV_{CC} + 0.3 \text{ V}$ when CIN input is selected.
When a pin is in output mode, the output voltage is equivalent to the applied voltage.
7. Current dissipation values are for $V_{IH} \text{ min} = V_{CC} - 0.2 \text{ V}$ and $V_{IL} \text{ max} = 0.2 \text{ V}$ with all output pins unloaded and the on-chip pull-up MOSs in the off state.
8. The values are for $V_{RAM} \leq V_{CC} < 4.0 \text{ V}$, $V_{IH} \text{ min} = V_{CC} - 0.2 \text{ V}$, and $V_{IL} \text{ max} = 0.2 \text{ V}$.

Table 25.16 DC Characteristics (3)

Conditions: $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}^{*7}$, $AV_{CC}^{*1} = 2.7 \text{ V to } 3.6 \text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0 \text{ V}$,
 $T_a = -20 \text{ to } +75^\circ\text{C}$

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | | |
|--|---|-----|-----------------|----------------------|------|---------------------|---|---|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *6} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | (1) | V_T^- | $V_{CC} \times 0.2$ | — | — | V | |
| | | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| Schmitt trigger input voltage (in level switching) ^{*6} | P67 to P60 (KWUL = 01) | | V_T^- | $V_{CC} \times 0.3$ | — | — | V | |
| | | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | P67 to P60 (KWUL = 10) | | V_T^- | $V_{CC} \times 0.4$ | — | — | V | |
| | | | V_T^+ | — | — | $V_{CC} \times 0.8$ | V | |
| | P67 to P60 (KWUL = 11) | | V_T^- | $V_{CC} \times 0.45$ | — | — | V | |
| | | | V_T^+ | — | — | $V_{CC} \times 0.9$ | V | |
| | | | $V_T^+ - V_T^-$ | 0.05 | — | — | V | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 EXTAL Port 7 Input pins except (1) and (2) above | (2) | V_{IH} | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | | | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | | | $V_{CC} \times 0.7$ | — | $AV_{CC} + 0.3$ | V | |
| | | | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | RES, STBY, MD1, MD0 NMI, EXTAL, input pins except (1) and (3) above | (3) | V_{IL} | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | | | | -0.3 | — | $V_{CC} \times 0.2$ | V | |
| Output high voltage | All output pins (except P97, and P52 ^{*4, *5}) P97, P52 ^{*4} | | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu\text{A}$ |
| | | | | $V_{CC} - 1.0$ | — | — | V | $I_{OH} = -1 \text{ mA}$ |
| | | | | 0.5 | — | — | V | $I_{OH} = -200 \mu\text{A}$, $V_{CC} = 2.7 \text{ to } 3.5 \text{ V}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test | |
|---|-----------------------------------|-------------|-----|------|------|---------------|---|-----------------------------|
| | | | | | | | Conditions | |
| Output low voltage | All output pins ^{*5} | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6\text{mA}$ | |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 5\text{mA}$ | |
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5\text{ to } V_{CC} - 0.5\text{ V}$ | |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to } AV_{CC} - 0.5\text{ V}$ | |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSL} $ | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to } V_{CC} - 0.5\text{ V}$ | |
| Input pull-up MOS current | Ports 1 to 3 | $-I_p$ | 5 | — | 150 | μA | $V_{in} = 0\text{ V}, V_{CC} = 2.7\text{ V to } 3.6\text{ V}$ | |
| | Port 6 (P6PUE = 0) | | 30 | — | 300 | μA | | |
| | Port 6 (P6PUE = 1) | | 3 | — | 100 | μA | | |
| Input capacitance | \overline{RES} (4) | C_{in} | — | — | 80 | pF | $V_{in} = 0\text{ V}, f = 1\text{ MHz}, T_a = 25^\circ\text{C}$ | |
| | NMI | | — | — | 50 | pF | | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | | |
| | Input pins except (4) above | | — | — | 15 | pF | | |
| Current dissipation ^{*8} | Normal operation | I_{CC} | — | 30 | 40 | mA | $f = 10\text{ MHz}$ | |
| | Sleep mode | | — | 20 | 32 | mA | $f = 10\text{ MHz}$ | |
| | Standby mode ^{*9} | | — | — | 1.0 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | — | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0\text{ V to } 3.6\text{ V}$ | |
| Analog power supply voltage ^{*1} | | AV_{CC} | 2.7 | — | 3.6 | V | Operating | |
| | | | 2.0 | — | 3.6 | V | Idle/not used | |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AVCC by connection to the power supply (V_{CC}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.

3. $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.
4. P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs in H8S/2138.
An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1).
P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS in H8S/2138.
5. When ICE = 0. Low-level output when the bus drive function is selected is determined separately.
6. The upper limit of the port 6 applied voltage is $V_{\text{CC}} + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{\text{CC}} + 0.3 \text{ V}$ and $A V_{\text{CC}} + 0.3 \text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
7. For flash memory program/erase operations, the applicable ranges are $V_{\text{CC}} = 3.0 \text{ V}$ to 3.6 V .
8. Current dissipation values are for $V_{\text{IH min}} = V_{\text{CC}} - 0.2 \text{ V}$ and $V_{\text{IL max}} = 0.2 \text{ V}$ with all output pins unloaded and the on-chip pull-up MOSs in the off state.
9. The values are for $V_{\text{RAM}} \leq V_{\text{CC}} < 2.7 \text{ V}$, $V_{\text{IH min}} = V_{\text{CC}} - 0.2 \text{ V}$, and $V_{\text{IL max}} = 0.2 \text{ V}$.

Table 25.17 Permissible Output Currents

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications),
 $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0 | I_{OL} | — | — | 20 | mA |
| | Ports 1 to 3 | | — | — | 10 | mA |
| | Other output pins | | — | — | 2 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 80 | mA |
| | Total of all output pins, including the above | | — | — | 120 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | — | — | 40 | mA |

Conditions: $V_{CC} = 2.7\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0 | I_{OL} | — | — | 10 | mA |
| | Ports 1 to 3 | | — | — | 2 | mA |
| | Other output pins | | — | — | 1 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 40 | mA |
| | Total of all output pins, including the above | | — | — | 60 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | — | — | 30 | mA |

- Notes: 1. To protect chip reliability, do not exceed the output current values in table 25.17.
 2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 25.1 and 25.2.

Table 25.18 Bus Drive Characteristics

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ (3-V version), $V_{SS} = 0\text{ V}$,
 $T_a = -20\text{ to }+75^\circ\text{C}$

Applicable Pins: SCL1, SCL0, SDA1, SDA0 (bus drive function selected)

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|-----------------|----------------------|-----|---------------------|---------------|--|
| Schmitt trigger input voltage | V_T^- | $V_{CC} \times 0.3$ | — | — | V | |
| | V_T^+ | — | — | $V_{CC} \times 0.7$ | | |
| | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | | |
| Input high voltage | V_{IH} | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.5$ | V | |
| Input low voltage | V_{IL} | -0.5 | — | $V_{CC} \times 0.3$ | | |
| Output low voltage | V_{OL} | — | — | 0.8 | V | $I_{OL} = 16\text{ mA}$, $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ |
| | | | | 0.5 | | $I_{OL} = 8\text{ mA}$ |
| | | | | 0.4 | | $I_{OL} = 3\text{ mA}$ |
| Input capacitance | C_{in} | — | — | 20 | pF | $V_{in} = 0\text{ V}$, $f = 1\text{ MHz}$, $T_a = 25^\circ\text{C}$ |
| Three-state leakage current (off state) | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |
| SCL, SDA output fall time | t_{of} | $20 + 0.1Cb$ | — | 250 | ns | |

25.3.3 AC Characteristics

Clock timing, control signal timing, bus timing, and timing of on-chip supporting modules list the following.

Figure 25.4 shows the test conditions for the AC characteristics.

(1) Clock Timing

Table 25.19 shows the clock timing. The clock timing specified here covers clock (ϕ) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details of external clock input (EXTAL pin and EXCL pin) timing, see section 23, Clock Pulse Generator.

Table 25.19 Clock Timing

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 3.6 V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|---|------------|-------------|-----|-------------|-----|-------------|-----|---------------|----------------------------|
| | | Min | Max | Min | Max | Min | Max | | |
| Clock cycle time | t_{cyc} | 50 | 500 | 62.5 | 500 | 100 | 500 | ns | Figure 25.5 |
| Clock high pulse width | t_{CH} | 17 | — | 20 | — | 30 | — | ns | |
| Clock low pulse width | t_{CL} | 17 | — | 20 | — | 30 | — | ns | |
| Clock rise time | t_{Cr} | — | 8 | — | 10 | — | 20 | ns | |
| Clock fall time | t_{Cf} | — | 8 | — | 10 | — | 20 | ns | |
| Oscillation settling time at reset (crystal) | t_{OSC1} | 10 | — | 10 | — | 20 | — | ms | Figure 25.6 Figure 25.7 |
| Oscillation settling time in software standby (crystal) | t_{OSC2} | 8 | — | 8 | — | 8 | — | ms | |
| External clock output stabilization delay time | t_{DEXT} | 500 | — | 500 | — | 500 | — | μs | |

(2) Control Signal Timing

Table 25.20 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768$ kHz) are NMI and IRQ0, IRQ1, IRQ2, IRQ6, and IRQ7.

Table 25.20 Control Signal Timing

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7$ V to 3.6 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|--|-------------------|-------------|-----|-------------|-----|-------------|-----|------------------|-----------------|
| | | 20 MHz | Max | 16 MHz | Max | 10 MHz | Max | | |
| $\overline{\text{RES}}$ setup time | t_{RESS} | 200 | — | 200 | — | 300 | — | ns | Figure 25.8 |
| $\overline{\text{RES}}$ pulse width | t_{RESW} | 20 | — | 20 | — | 20 | — | t_{cyc} | |
| NMI setup time (NMI) | t_{NMIS} | 150 | — | 150 | — | 250 | — | ns | Figure 25.9 |
| NMI hold time (NMI) | t_{NMIH} | 10 | — | 10 | — | 10 | — | | |
| NMI pulse width (exiting software standby mode) | t_{NMIW} | 200 | — | 200 | — | 200 | — | ns | |
| IRQ setup time (IRQ7 to $\overline{\text{IRQ0}}$) | t_{IRQS} | 150 | — | 150 | — | 250 | — | ns | |
| IRQ hold time (IRQ7 to $\overline{\text{IRQ0}}$) | t_{IRQH} | 10 | — | 10 | — | 10 | — | ns | |
| IRQ pulse width ($\overline{\text{IRQ7}}$, $\overline{\text{IRQ6}}$, $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}$) (exiting software standby mode) | t_{IRQW} | 200 | — | 200 | — | 200 | — | ns | |

(3) Bus Timing

Table 25.21 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768$ kHz).

Table 25.21 Bus Timing

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7$ V to 3.6 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|----------------------------------|------------|---------------------------|-----|---------------------------|-----|---------------------------|-----|------|------------------------------|
| | | Min | Max | Min | Max | Min | Max | | |
| Address delay time | t_{AD} | — | 20 | — | 30 | — | 40 | ns | Figure 25.10 to figure 25.14 |
| Address setup time | t_{AS} | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | $0.5 \times t_{cyc} - 30$ | — | ns | |
| Address hold time | t_{AH} | $0.5 \times t_{cyc} - 10$ | — | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | ns | |
| \overline{CS} delay time (IOS) | t_{CSD} | — | 20 | — | 30 | — | 40 | ns | |
| \overline{AS} delay time | t_{ASD} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 1 | t_{RSD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 2 | t_{RSD2} | — | 30 | — | 45 | — | 60 | ns | |
| Read data setup time | t_{RDS} | 15 | — | 20 | — | 35 | — | ns | |
| Read data hold time | t_{RDH} | 0 | — | 0 | — | 0 | — | ns | |

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|-------------------------------|------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|------|------------------------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| Read data access time 1 | t_{ACC1} | — | $1.0 \times t_{cyc} - 30$ | — | $1.0 \times t_{cyc} - 40$ | — | $1.0 \times t_{cyc} - 60$ | ns | Figure 25.10 to figure 25.14 |
| Read data access time 2 | t_{ACC2} | — | $1.5 \times t_{cyc} - 25$ | — | $1.5 \times t_{cyc} - 35$ | — | $1.5 \times t_{cyc} - 50$ | ns | |
| Read data access time 3 | t_{ACC3} | — | $2.0 \times t_{cyc} - 30$ | — | $2.0 \times t_{cyc} - 40$ | — | $2.0 \times t_{cyc} - 60$ | ns | |
| Read data access time 4 | t_{ACC4} | — | $2.5 \times t_{cyc} - 25$ | — | $2.5 \times t_{cyc} - 35$ | — | $2.5 \times t_{cyc} - 50$ | ns | |
| Read data access time 5 | t_{ACC5} | — | $3.0 \times t_{cyc} - 30$ | — | $3.0 \times t_{cyc} - 40$ | — | $3.0 \times t_{cyc} - 60$ | ns | |
| \overline{WR} delay time 1 | t_{WRD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} delay time 2 | t_{WRD2} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} pulse width 1 | t_{WSW1} | $1.0 \times t_{cyc} - 20$ | — | $1.0 \times t_{cyc} - 30$ | — | $1.0 \times t_{cyc} - 40$ | — | ns | |
| \overline{WR} pulse width 2 | t_{WSW2} | $1.5 \times t_{cyc} - 20$ | — | $1.5 \times t_{cyc} - 30$ | — | $1.5 \times t_{cyc} - 40$ | — | ns | |
| Write data delay time | t_{WDD} | — | 30 | — | 45 | — | 60 | ns | |
| Write data setup time | t_{WDS} | 0 | — | 0 | — | 0 | — | ns | |
| Write data hold time | t_{WDH} | 10 | — | 15 | — | 20 | — | ns | |
| \overline{WAIT} setup time | t_{WTS} | 30 | — | 45 | — | 60 | — | ns | |
| \overline{WAIT} hold time | t_{WTH} | 5 | — | 5 | — | 10 | — | ns | |

(4) Timing of On-Chip Supporting Modules

Tables 25.22 and 25.23 show the on-chip supporting module timing. The only on-chip supporting modules that can operate in subclock operation ($\phi = 32.768$ kHz) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 25.22 Timing of On-Chip Supporting Modules (1)

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 32.768$ kHz*, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz*, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7$ V to 3.6 V, $V_{SS} = 0$ V, $\phi = 32.768$ kHz*, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|------------|------------------------------|-------------|-------------|-------------|-----|-------------|-----|------|-----------------|--------------|
| | | Min | Max | Min | Max | Min | Max | | | |
| I/O ports | Output data delay time | t_{PWD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.15 |
| | Input data setup time | t_{PRS} | 30 | — | 30 | — | 50 | — | | |
| | Input data hold time | t_{PRH} | 30 | — | 30 | — | 50 | — | | |
| FRT | Timer output delay time | t_{FTOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.16 |
| | Timer input setup time | t_{FTIS} | 30 | — | 30 | — | 50 | — | | |
| | Timer clock input setup time | t_{FTCS} | 30 | — | 30 | — | 50 | — | | Figure 25.17 |
| | Timer clock pulse width | Single edge | t_{FTCWH} | 1.5 | — | 1.5 | — | 1.5 | — | t_{cyc} |
| Both edges | | t_{FTCWL} | 2.5 | — | 2.5 | — | 2.5 | — | | |

| Item | | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|--------------------------------------|--|--------------|-------------|-----|-------------|-----|-------------|-----|------------|-----------------|--------------|
| | | | 20 MHz | | 16 MHz | | 10 MHz | | | | |
| | | | Min | Max | Min | Max | Min | Max | | | |
| TMR | Timer output delay time | t_{TOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.18 | |
| | Timer reset input setup time | t_{TMRs} | 30 | — | 30 | — | 50 | — | | Figure 25.20 | |
| | Timer clock input setup time | t_{TMCS} | 30 | — | 30 | — | 50 | — | | Figure 25.19 | |
| | Timer clock pulse width | Single edge | t_{TMCWH} | 1.5 | — | 1.5 | — | 1.5 | — | t_{cyc} | |
| | | Both edges | t_{TMCWL} | 2.5 | — | 2.5 | — | 2.5 | — | | |
| PWM, PWMX | Pulse output delay time | t_{PWOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.21 | |
| SCI | Input clock cycle | Asynchronous | t_{Scyc} | 4 | — | 4 | — | 4 | — | t_{cyc} | Figure 25.22 |
| | | Synchronous | | 6 | — | 6 | — | 6 | — | | |
| | Input clock pulse width | t_{SCKW} | 0.4 | 0.6 | 0.4 | 0.6 | 0.4 | 0.6 | t_{Scyc} | | |
| | Input clock rise time | t_{SCKr} | — | 1.5 | — | 1.5 | — | 1.5 | t_{cyc} | | |
| | Input clock fall time | t_{SCKf} | — | 1.5 | — | 1.5 | — | 1.5 | | | |
| | Transmit data delay time (synchronous) | t_{TXD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.23 | |
| | Receive data setup time (synchronous) | t_{RXS} | 50 | — | 50 | — | 100 | — | ns | | |
| Receive data hold time (synchronous) | t_{RXH} | 50 | — | 50 | — | 100 | — | ns | | | |
| A/D converter | Trigger input setup time | t_{TRGS} | 30 | — | 30 | — | 50 | — | ns | Figure 25.24 | |

Note: * Only supporting modules that can be used in subclock operation.

Table 25.22 Timing of On-Chip Supporting Modules (2)

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7\text{ V}$ to 3.6 V , $V_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|-----------------|---|------------------------|------------------|-------------|-----|-------------|-----|------|-----------------|--------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | | |
| | | Min | Max | Min | Max | Min | Max | | | |
| HIF read cycle | $\overline{\text{CS}}/\text{HA0}$ setup item | t_{HAR} | 10 | — | 10 | — | 10 | — | ns | Figure 25.25 |
| | $\overline{\text{CS}}/\text{HA0}$ hold time | t_{HRA} | 10 | — | 10 | — | 10 | — | ns | |
| | $\overline{\text{IO}}\overline{\text{R}}$ pulse width | t_{HRPW} | 120 | — | 120 | — | 220 | — | ns | |
| | HDB delay time | t_{HRD} | — | 100 | — | 100 | — | 200 | ns | |
| | HDB hold time | t_{HRF} | 0 | 25 | 0 | 25 | 0 | 40 | ns | |
| | HIRQ delay time | t_{HIRQ} | — | 120 | — | 120 | — | 200 | ns | |
| HIF write cycle | $\overline{\text{CS}}/\text{HA0}$ setup item | t_{HAW} | 10 | — | 10 | — | 10 | — | ns | |
| | $\overline{\text{CS}}/\text{HA0}$ hold time | t_{HWA} | 10 | — | 10 | — | 10 | — | ns | |
| | $\overline{\text{IO}}\overline{\text{W}}$ pulse width | t_{HWPW} | 60 | — | 60 | — | 100 | — | ns | |
| | HDB setup time | Fast A20 gate not used | t_{HDW} | 30 | — | 30 | — | 50 | — | ns |
| | | Fast A20 gate used | | 45 | — | 55 | — | 85 | — | ns |
| | HDB hold time | t_{HWD} | 15 | — | 15 | — | 25 | — | ns | |
| | GA20 delay time | t_{HGA} | — | 90 | — | 90 | — | 180 | ns | |

Table 25.23 I²C Bus Timing

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ (3-V version), $V_{SS} = 0\text{ V}$, $\phi = 5\text{ MHz}$ to maximum operating frequency, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | Symbol | Ratings | | | Unit | Test Conditions | Notes |
|---|------------|---------|-----|------|-----------|-----------------|--------------|
| | | Min | Typ | Max | | | |
| SCL clock cycle time | t_{SCL} | 12 | — | — | t_{cyc} | | Figure 25.26 |
| SCL clock high pulse width | t_{SCLH} | 3 | — | — | t_{cyc} | | |
| SCL clock low pulse width | t_{SCLL} | 5 | — | — | t_{cyc} | | |
| SCL, SDA input rise time | t_{Sr} | — | — | 7.5* | t_{cyc} | | |
| SCL, SDA input fall time | t_{Sf} | — | — | 300 | ns | | |
| SCL, SDA input spike pulse elimination time | t_{SP} | — | — | 1 | t_{cyc} | | |
| SDA input bus free time | t_{BUF} | 5 | — | — | t_{cyc} | | |
| Start condition input hold time | t_{STAH} | 3 | — | — | t_{cyc} | | |
| Retransmission start condition input setup time | t_{STAS} | 3 | — | — | t_{cyc} | | |
| Stop condition input setup time | t_{STOS} | 3 | — | — | t_{cyc} | | |
| Data input setup time | t_{SDAS} | 0.5 | — | — | t_{cyc} | | |
| Data input hold time | t_{SDAH} | 0 | — | — | ns | | |
| SCL, SDA capacitive load | C_b | — | — | 400 | pF | | |

Note: * $17.5t_{cyc}$ can be set according to the clock selected for use by the I²C module. For details, see section 16.4, Usage Notes.

25.3.4 A/D Conversion Characteristics

Tables 25.24 and 25.25 list the A/D conversion characteristics.

Table 25.24 A/D Conversion Characteristics
(AN7 to AN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 3.6 V , $AV_{CC} = 2.7 \text{ V}$ to 3.6 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|-----------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time*3 | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | 5 | k Ω |
| Nonlinearity error | — | — | ± 3.0 | — | — | ± 3.0 | — | — | ± 7.0 | LSB |
| Offset error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Full-scale error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 4.0 | — | — | ± 4.0 | — | — | ± 8.0 | LSB |

Notes: 1. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)

2. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)

3. In single mode and $\phi =$ maximum operating frequency.

Table 25.25 A/D Conversion Characteristics
(CIN7 to CIN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0 \text{ V}$ to 3.6 V^{*4} , $AV_{CC} = 3.0 \text{ V}$ to 3.6 V^{*4} , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|------------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time ^{*3} | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | 5 | k Ω |
| Nonlinearity error | — | — | ± 5.0 | — | — | ± 5.0 | — | — | ± 11.0 | LSB |
| Offset error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Full-scale error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 6.0 | — | — | ± 6.0 | — | — | ± 12.0 | LSB |

- Notes: 1. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)
2. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)
3. In single mode and $\phi =$ maximum operating frequency.
4. When using CIN, the applicable range is $V_{CC} = 3.0 \text{ V}$ to 3.6 V and $AV_{CC} = 3.0 \text{ V}$ to 3.6 V .

25.3.5 D/A Conversion Characteristics

Table 25.26 lists the D/A conversion characteristics.

Table 25.26 D/A Conversion Characteristics

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 3.6 V , $AV_{CC} = 2.7 \text{ V}$ to 3.6 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------|-----------------------------------|-------------|-----------|-----------|-------------|-----------|-----------|-------------|-----------|-----------|---------------|
| | | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | Bits |
| Conversion time | With 20-pF load capacitance | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| Absolute accuracy | With 2-M Ω load resistance | — | ± 1.0 | ± 1.5 | — | ± 1.0 | ± 1.5 | — | ± 2.0 | ± 3.0 | LSB |
| | With 4-M Ω load resistance | — | — | ± 1.0 | — | — | ± 1.0 | — | — | ± 2.0 | |

25.3.6 Flash Memory Characteristics

Table 25.27 shows the flash memory characteristics.

Table 25.27 Flash Memory Characteristics (Programming/Erasing Operating Range)

Conditions (5-V version): $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications), $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

(3-V version): $V_{CC} = 3.0\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | Symbol | Min | Typ | Max | Unit | Test Condition | |
|--|--|---|---------------------|------|------------------|----------------|--------------------|
| Programming time ^{*1 *2 *4} | tP | — | 10 | 200 | ms/ 128 bytes | | |
| Erase time ^{*1 *3 *6} | tE | — | 100 | 1200 | ms/block | | |
| Reprogramming count | N _{WEC} | 100 ^{*8} | 10000 ^{*9} | — | Times | | |
| Data retention time ^{*10} | t _{DRP} | 10 | — | — | Years | | |
| Programming | Wait time after SWE-bit setting ^{*1} | x | 1 | — | — | μs | |
| | Wait time after PSU-bit setting ^{*1} | y | 50 | — | — | μs | |
| | Wait time after P-bit setting ^{*1 *4} | z1 | 28 | 30 | 32 | μs | 1 ≤ n ≤ 6 |
| | | z2 | 198 | 200 | 202 | μs | 7 ≤ n ≤ 1000 |
| | | z3 | 8 | 10 | 12 | μs | Additional writing |
| | Wait time after P-bit clear ^{*1} | α | 5 | — | — | μs | |
| | Wait time after PSU-bit clear ^{*1} | β | 5 | — | — | μs | |
| | Wait time after PV-bit setting ^{*1} | γ | 4 | — | — | μs | |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs | |
| | Wait time after PV-bit clear ^{*1} | η | 2 | — | — | μs | |
| | Wait time after SWE-bit clear ^{*1} | θ | 100 | — | — | μs | |
| | Maximum programming count ^{*1 *4 *5} | N | — | — | 1000 | Times | |
| | Erase | Wait time after SWE-bit setting ^{*1} | x | 1 | — | — | μs |
| Wait time after ESU-bit setting ^{*1} | | y | 100 | — | — | μs | |
| Wait time after E-bit setting ^{*1 *6} | | z | 10 | — | 100 | ms | |
| Wait time after E-bit clear ^{*1} | | α | 10 | — | — | μs | |
| Wait time after ESU-bit clear ^{*1} | | β | 10 | — | — | μs | |
| Wait time after EV-bit setting ^{*1} | | γ | 20 | — | — | μs | |
| Wait time after dummy write ^{*1} | | ε | 2 | — | — | μs | |
| Wait time after EV-bit clear ^{*1} | | η | 4 | — | — | μs | |
| Wait time after SWE-bit clear ^{*1} | | θ | 100 | — | — | μs | |
| Maximum erase count ^{*1 *6 *7} | | N | — | — | 120 | Times | |

- Notes:
1. Set the times according to the program/erase algorithms.
 2. Programming time per 128 bytes (Shows the total period for which the P-bit in the flash memory control register (FLMCR1) is set. It does not include the programming verification time.)
 3. Block erase time (shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
 4. Maximum programming time (t_P (max))

$$t_P \text{ (max)} = (\text{wait time after P-bit setting (z1)} + \text{(z3)}) \times 6 + \text{wait time after P-bit setting (z2)} \times ((N) - 6)$$
 5. Maximum programming count (N) should be set according to the actual set value of (z1, z2, z3) to allow programming within the maximum programming time (t_P (max)). The wait time after P-bit setting (z1, z2, z3) must be changed with the value of the number of writing times (n) as follows.
 The number of times for writing n

$$1 \leq n \leq 6 \quad z1 = 30 \mu\text{s}, z3 = 10 \mu\text{s}$$

$$7 \leq n \leq 1000 \quad z2 = 200 \mu\text{s}$$
 6. Maximum erase time (t_E (max))

$$t_E \text{ (max)} = \text{Waiting time after E-bit setting (z)} \times \text{Maximum erase count (N)}.$$
 7. Maximum erase count (N) should be set according to the actual setting (z) to allow erase within the maximum erase time (t_E (max)).
 8. Minimum number of times for which all characteristics are guaranteed after rewriting (Guarantee range is 1 to minimum value).
 9. Reference value for 25°C (as a guideline, rewriting should normally function up to this value).
 10. Data retention characteristic when rewriting is performed within the specification range, including the minimum value.

25.3.7 Usage Note

- (1) The F-ZTAT and mask ROM versions have been confirmed as fully meeting the reference values for electrical characteristics shown in this manual. However, actual performance figures, operating margins, noise margins, and other properties may vary due to differences in the manufacturing process, on-chip ROM, layout patterns, etc.

When system evaluation testing is carried out using the F-ZTAT version, the same evaluation tests should also be conducted for the mask ROM version when changing over to that version.

- (2) On-chip power supply step-down circuit

The following products incorporate an internal power supply step-down circuit, which automatically drops down the internal power supply voltage to the optimum internal voltage level: the F-ZTAT A-mask version of the H8S/2138 (HD64F2138A) and the mask ROM versions of the H8S/2138 and H8S/2137 (HD6432138S, HD6432138SW, HD6432137S, and HD6432137SW).

The voltage-stabilization capacitor (0.47 μ F one or two connected in series) must be connected between the VCL (internal power supply step-down) and V_{ss} pins.

Figure 25.3 shows the connection of the external capacitors.

For the 5- or 4-V version whose power supply (V_{cc}) voltage exceeds 3.6 V, do not connect the VCL pin in a product incorporating an internal step-down circuit to the V_{cc} power supply. (Connect the VCC1 pin to the V_{cc} power supply as usual.) For the 3-V version whose power supply (V_{cc}) voltage is 3.6 V or lower, connect both the VCL and VCC1 pins to the system power supply.

When changing from the F-ZTAT versions not incorporating an internal step-down circuit to the F-ZTAT A-mask versions or mask ROM versions incorporating an internal step-down circuit, the VCL pin has the same pin location as the VCC2 pin.

Therefore, note that the circuit patterns differ between these two types of products.

25.4 Electrical Characteristics of H8S/2134 F-ZTAT, H8S/2132 F-ZTAT, and Mask ROM Versions of H8S/2132 and H8S/2130

25.4.1 Absolute Maximum Ratings

Table 25.28 lists the absolute maximum ratings.

Table 25.28 Absolute Maximum Ratings

| Item | Symbol | Value | Unit |
|--|-----------|---|------|
| Power supply voltage* | V_{CC} | -0.3 to +7.0 | V |
| Input voltage (except ports 6 and 7) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input not selected for port 6) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input selected for port 6) | V_{in} | Lower voltage of -0.3 to $V_{CC} + 0.3$ and $AV_{CC} + 0.3$ | V |
| Input voltage (port 7) | V_{in} | -0.3 to $AV_{CC} + 0.3$ | V |
| Analog power supply voltage | AV_{CC} | -0.3 to +7.0 | V |
| Analog input voltage | V_{AN} | -0.3 to $AV_{CC} + 0.3$ | V |
| Operating temperature | T_{opr} | Regular specifications: -20 to +75 | °C |
| | | Wide-range specifications: -40 to +85 | °C |
| Operating temperature (flash memory programming/erasing) | T_{opr} | Regular specifications: 0 to +75 | °C |
| | | Wide-range specifications: 0 to +85 | °C |
| Storage temperature | T_{stg} | -55 to +125 | °C |

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

* Voltage applied to the VCC1 and VCC2 pins.

25.4.2 DC Characteristics

Table 25.29 lists the DC characteristics. Table 25.30 lists the permissible output currents.

Table 25.29 DC Characteristics (1)

Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC}^{*1} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS}^{*1} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^\circ\text{C}^{*5}$ (regular specifications), $T_a = -40 \text{ to } +85^\circ\text{C}^{*5}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|-------------------------------|--|--|---------------------|-----|---------------------|---------------|--|
| Schmitt trigger input voltage | P67 to P60 ^{*2 *4} , $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}^{*3}$, $\overline{\text{IRQ5}}$ to $\overline{\text{IRQ3}}$ | (1) V_T^- | 1.0 | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | |
| Input high voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, NMI, MD1, MD0 | (2) V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | EXTAL | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | Port 7 | 2.0 | — | $AV_{CC} + 0.3$ | V | |
| | | Input pins except (1) and (2) above | 2.0 | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, MD1, MD0 | (3) V_{IL} | -0.3 | — | 0.5 | V | |
| | | NMI, EXTAL, input pins except (1) and (3) above | -0.3 | — | 0.8 | V | |
| Output high voltage | All output pins | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu\text{A}$ |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$ |
| Output low voltage | All output pins | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6 \text{ mA}$ |
| | | | Ports 1 to 3 | — | — | 1.0 | V |
| Input leakage current | $\overline{\text{RES}}$ | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$ |
| | $\overline{\text{STBY}}$, NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|-----------------------------|--------------|-----|------|-----|---------------|---|
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5$ to $V_{cc} - 0.5$ V |
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 50 | — | 300 | μA | $V_{in} = 0$ V, $V_{cc} = 5$ V $\pm 10\%$ |
| | Port 6 | | 60 | — | 500 | μA | |
| Input capacitance | $\overline{\text{RES}}$ | (4) C_{in} | — | — | 80 | pF | $V_{in} = 0$ V, $f = 1$ MHz, $T_a = 25^\circ\text{C}$ |
| | $\overline{\text{NMI}}$ | | — | — | 50 | pF | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | |
| | Input pins except (4) above | | — | — | 15 | pF | |
| Current dissipation* ⁶ | Normal operation | I_{cc} | — | 75 | 100 | mA | $f = 20$ MHz |
| | Sleep mode | | — | 60 | 85 | mA | $f = 20$ MHz |
| | Standby mode* ⁷ | | — | 0.01 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| Analog power supply current | During A/D, D/A conversion | AI_{cc} | — | 3.2 | 7.0 | mA | $AV_{cc} = 2.0$ V to 5.5 V |
| | Idle | | — | 0.01 | 5.0 | μA | |
| Analog power supply voltage* ¹ | | AV_{cc} | 4.5 | — | 5.5 | V | Operating |
| | | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{cc}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.
4. The upper limit of the port 6 applied voltage is $V_{cc} + 0.3$ V when CIN input is not selected, and the lower of $V_{cc} + 0.3$ V and $AV_{cc} + 0.3$ V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
5. For flash memory program/erase operations, the applicable range is $T_a = 0$ to $+75^\circ\text{C}$ (regular specifications) or $T_a = 0$ to $+85^\circ\text{C}$ (wide-range specifications).
6. Current dissipation values are for $V_{IH} \text{ min} = V_{cc} - 0.5$ V and $V_{IL} \text{ max} = 0.5$ V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
7. The values are for $V_{RAM} \leq V_{cc} < 4.5$ V, $V_{IH} \text{ min} = V_{cc} \times 0.9$, and $V_{IL} \text{ max} = 0.3$ V.

Table 25.29 DC Characteristics (2)

Conditions: $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}^{*5}$, $AV_{CC}^{*1} = 4.0 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^\circ\text{C}^{*5}$ (regular specifications), $T_a = -40 \text{ to } +85^\circ\text{C}^{*5}$ (wide-range specifications)

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|-------------------------------|---|-----------------|---------------------|-----------------|---------------------|-----------------|--|
| Schmitt trigger input voltage | $\overline{\text{P67}}$ to $\overline{\text{P60}}^{*2 *4}$, (1) $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}^{*3}$, $\overline{\text{IRQ5}}$ to $\overline{\text{IRQ3}}$ | V_T^- | 1.0 | — | — | V | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | $V_{CC} < 4.5 \text{ V}$ |
| | | V_T^- | 0.8 | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.3 | — | — | V | |
| Input high voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, (2) $\overline{\text{NMI}}$, $\overline{\text{MD1}}$, $\overline{\text{MD0}}$ | V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | $\overline{\text{EXTAL}}$ | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | Port 7 | 2.0 | — | $AV_{CC} + 0.3$ | V | | |
| | Input pins except (1) and (2) above | 2.0 | — | $V_{CC} + 0.3$ | V | | |
| Input low voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, (3) $\overline{\text{MD1}}$, $\overline{\text{MD0}}$ | V_{IL} | -0.3 | — | 0.5 | V | |
| | $\overline{\text{NMI}}$, $\overline{\text{EXTAL}}$, input pins except (1) and (3) above | | -0.3 | — | 0.8 | V | |
| Output high voltage | All output pins | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200 \mu\text{A}$ |
| | | | 3.5 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | | | 3.0 | — | — | V | $I_{OH} = -1 \text{ mA}$, $V_{CC} < 4.5 \text{ V}$ |
| Output low voltage | All output pins | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6 \text{ mA}$ |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 10 \text{ mA}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|-----------------------------------|-------------|-----|------|------|---------|---|
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5$ to $V_{cc} - 0.5 V$ |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5$ to $AV_{cc} - 0.5 V$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSL} $ | — | — | 1.0 | μA | $V_{in} = 0.5$ to $V_{cc} - 0.5 V$ |
| Input pull-up MOS current | Ports 1 to 3 | $-I_p$ | 50 | — | 300 | μA | $V_{in} = 0 V$, $V_{cc} = 4.5 V$ to $5.5 V$ |
| | Port 6 | | 60 | — | 500 | μA | |
| | Ports 1 to 3 | | 30 | — | 200 | μA | $V_{in} = 0 V$, $V_{cc} < 4.5 V$ |
| | Port 6 | | 40 | — | 400 | μA | |
| Input capacitance | \overline{RES} (4) | C_{in} | — | — | 80 | pF | $V_{in} = 0 V$, $f = 1 MHz$, $T_a = 25^\circ C$ |
| | NMI | | — | — | 50 | pF | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | |
| | Input pins except (4) above | | — | — | 15 | pF | |
| Current dissipation*6 | Normal operation | I_{cc} | — | 65 | 85 | mA | $f = 16 MHz$ |
| | Sleep mode | | — | 50 | 70 | mA | $f = 16 MHz$ |
| | Standby mode*7 | | — | 0.01 | 5.0 | μA | $T_a \leq 50^\circ C$ |
| | | | — | — | 20.0 | μA | $50^\circ C < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{cc} | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{cc} = 2.0 V$ to $5.5 V$ |
| Analog power supply voltage*1 | | AV_{cc} | 4.0 | — | 5.5 | V | Operating |
| | | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{cc}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.

3. $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.
4. The upper limit of the port 6 applied voltage is $V_{\text{CC}} + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{\text{CC}} + 0.3 \text{ V}$ and $AV_{\text{CC}} + 0.3 \text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
5. Ranges of $V_{\text{CC}} = 4.5 \text{ to } 5.5 \text{ V}$, $T_{\text{a}} = 0 \text{ to } +75^{\circ}\text{C}$ (regular specifications), and $T_{\text{a}} = 0 \text{ to } +85^{\circ}\text{C}$ (wide-range specifications) must be observed for flash memory programming/erasing.
6. Current dissipation values are for $V_{\text{IH min}} = V_{\text{CC}} - 0.5 \text{ V}$ and $V_{\text{IL max}} = 0.5 \text{ V}$ with all output pins unloaded and the on-chip pull-up MOSs in the off state.
7. The values are for $V_{\text{RAM}} \leq V_{\text{CC}} < 4.0 \text{ V}$, $V_{\text{IH min}} = V_{\text{CC}} \times 0.9$, and $V_{\text{IL max}} = 0.3 \text{ V}$.

Table 25.29 DC Characteristics (3)

Conditions (Mask ROM version): $V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $AV_{CC}^{*1} = 2.7\text{ V to }5.5\text{ V}$,
 $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

(Flash memory version): $V_{CC} = 3.0\text{ V to }5.5\text{ V}^{*5}$, $AV_{CC}^{*1} = 3.0\text{ V to }5.5\text{ V}$,
 $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}^{*5}$

| Item | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|-------------------------------|--|---|----------------------|-----|----------------------------|-----------------|---|
| Schmitt trigger input voltage | P67 to P60 ^{*2 *4} , (1) $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}^{*3}$, $\overline{\text{IRQ5}}$ to $\overline{\text{IRQ3}}$ | V_T^- | $V_{CC} \times 0.2$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| Input high voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, (2) NMI, MD1, MD0 | V_{IH} | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | | EXTAL | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | | Port 7 | $V_{CC} \times 0.7$ | — | $AV_{CC} + 0.3$ | V | |
| | | Input pins except (1) and (2) above | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, (3) MD1, MD0 | V_{IL} | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | | NMI, EXTAL, input pins except (1) and (3) above | -0.3 | — | $V_{CC} \times 0.2$ 0.8 | V V | $V_{CC} < 4.0\text{ V}$ $V_{CC} = 4.0\text{ V to }5.5\text{ V}$ |
| Output high voltage | All output pins | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200\ \mu\text{A}$ |
| | | $V_{CC} - 1.0$ | — | — | — | V | $I_{OH} = -1\ \text{mA}$ ($V_{CC} < 4.0\text{ V}$) |
| Output low voltage | All output pins | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6\text{ mA}$ |
| | | Ports 1 to 3 | — | — | 1.0 | V | $I_{OL} = 5\ \text{mA}$ ($V_{CC} < 4.0\text{ V}$), $I_{OL} = 10\ \text{mA}$ ($4.0\text{ V} \leq V_{CC} \leq 5.5\text{ V}$) |
| Input leakage current | $\overline{\text{RES}}$ $\overline{\text{STBY}}$, NMI, MD1, MD0 | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |
| | | — | — | — | 1.0 | μA | |
| | | Port 7 | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }AV_{CC} - 0.5\text{ V}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|---|-----------------------------|-------------|-----|------|------|---------------|---|-----------------------------|
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5$ to $V_{CC} - 0.5$ V | |
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 10 | — | 150 | μA | $V_{in} = 0$ V, $V_{CC} = 2.7$ V ^{*5} to 3.6 V | |
| | Port 6 | | 30 | — | 250 | μA | | |
| Input capacitance | $\overline{\text{RES}}$ (4) | C_{in} | — | — | 80 | pF | $V_{in} = 0$ V, $f = 1$ MHz, $T_a = 25^\circ\text{C}$ | |
| | NMI | | — | — | 50 | pF | | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | | |
| | Input pins except (4) above | | — | — | 15 | pF | | |
| Current dissipation ^{*6} | Normal operation | I_{CC} | — | 45 | 60 | mA | $f = 10$ MHz | |
| | Sleep mode | | — | 35 | 50 | mA | $f = 10$ MHz | |
| | Standby mode ^{*7} | | | — | 0.01 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0$ V to 5.5 V | |
| Analog power supply voltage ^{*1} | | AV_{CC} | 2.7 | — | 5.5 | V | Operating (mask ROM version) | |
| | | | 3.0 | — | 5.5 | V | Operating (F-ZTAT version) | |
| | | | 2.0 | — | 5.5 | V | Idle/not used | |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | | |

- Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.
Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{CC}), or some other method.
2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.

4. The upper limit of the port 6 applied voltage is $V_{CC} + 0.3$ V when CIN input is not selected, and the lower of $V_{CC} + 0.3$ V and $AV_{CC} + 0.3$ V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
5. For flash memory program/erase operations, the applicable ranges are $V_{CC} = 3.0$ V to 3.6 V, $T_a = 0$ to $+75^\circ\text{C}$. For the F-ZTAT versions, the test condition is $V_{CC} = 3.0$ V or higher.
6. Current dissipation values are for $V_{IH} \text{ min} = V_{CC} - 0.5$ V and $V_{IL} \text{ max} = 0.5$ V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
7. The values are for $V_{RAM} \leq V_{CC} < 2.7$ V (mask ROM version), $V_{RAM} \leq V_{CC} < 3.0$ V (F-ZTAT version), $V_{IH} \text{ min} = V_{CC} \times 0.9$, and $V_{IL} \text{ max} = 0.3$ V.

Table 25.30 Permissible Output Currents

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications),
 $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | Ports 1, 2, 3 | I_{OL} | — | — | 10 | mA |
| | Other output pins | | — | — | 2 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 80 | mA |
| | Total of all output pins, including the above | | — | — | 120 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | — | — | 40 | mA |

Conditions: $V_{CC} = 2.7\text{ V to }5.5\text{ V}$ (mask ROM version), $V_{CC} = 3.0\text{ V to }5.5\text{ V}$ (F-ZTAT version),
 $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | Ports 1, 2, 3 | I_{OL} | — | — | 2 | mA |
| | Other output pins | | — | — | 1 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 40 | mA |
| | Total of all output pins, including the above | | — | — | 60 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | — | — | 30 | mA |

Notes: 1. To protect chip reliability, do not exceed the output current values in table 25.30.

2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 25.1 and 25.2.

25.4.3 AC Characteristics

Clock timing, control signal timing, bus timing, and timing of on-chip supporting modules list the following.

Figure 25.4 shows the test conditions for the AC characteristics.

(1) Clock Timing

Table 25.31 shows the clock timing. The clock timing specified here covers clock (ϕ) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details of external clock input (EXTAL pin and EXCL pin) timing, see section 23, Clock Pulse Generator.

Table 25.31 Clock Timing

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 5.5 V (mask ROM version), $V_{CC} = 3.0 \text{ V}$ to 5.5 V (F-ZTAT version),
 $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|---|------------|-------------|-----|-------------|-----|-------------|-----|---------------|----------------------------|
| | | 20 MHz | Max | 16 MHz | Max | 10 MHz | Max | | |
| Clock cycle time | t_{cyc} | 50 | 500 | 62.5 | 500 | 100 | 500 | ns | Figure 25.5 |
| Clock high pulse width | t_{CH} | 17 | — | 20 | — | 30 | — | ns | |
| Clock low pulse width | t_{CL} | 17 | — | 20 | — | 30 | — | ns | |
| Clock rise time | t_{Cr} | — | 8 | — | 10 | — | 20 | ns | |
| Clock fall time | t_{Cf} | — | 8 | — | 10 | — | 20 | ns | |
| Oscillation settling time at reset (crystal) | t_{OSC1} | 10 | — | 10 | — | 20 | — | ms | Figure 25.6 Figure 25.7 |
| Oscillation settling time in software standby (crystal) | t_{OSC2} | 8 | — | 8 | — | 8 | — | ms | |
| External clock output stabilization delay time | t_{DEXT} | 500 | — | 500 | — | 500 | — | μs | |

(2) Control Signal Timing

Table 25.32 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768$ kHz) are NMI and IRQ0, IRQ1, IRQ2, IRQ6, and IRQ7.

Table 25.32 Control Signal Timing

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7\text{ V}$ to 5.5 V (mask ROM version), $V_{CC} = 3.0\text{ V}$ to 5.5 V (F-ZTAT version),
 $V_{SS} = 0\text{ V}$, $\phi = 32.768$ kHz, 2 MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|--|-------------------|-------------|-----|-------------|-----|-------------|-----|------------------|-----------------|
| | | 20 MHz | Max | 16 MHz | Max | 10 MHz | Max | | |
| $\overline{\text{RES}}$ setup time | t_{RESS} | 200 | — | 200 | — | 300 | — | ns | Figure 25.8 |
| $\overline{\text{RES}}$ pulse width | t_{RESW} | 20 | — | 20 | — | 20 | — | t_{cyc} | |
| NMI setup time (NMI) | t_{NMIS} | 150 | — | 150 | — | 250 | — | ns | Figure 25.9 |
| NMI hold time (NMI) | t_{NMIH} | 10 | — | 10 | — | 10 | — | | |
| NMI pulse width (exiting software standby mode) | t_{NMIW} | 200 | — | 200 | — | 200 | — | ns | |
| IRQ setup time (IRQ7 to IRQ0) | t_{IRQS} | 150 | — | 150 | — | 250 | — | ns | |
| IRQ hold time (IRQ7 to IRQ0) | t_{IRQH} | 10 | — | 10 | — | 10 | — | ns | |
| IRQ pulse width (IRQ7, IRQ6, IRQ2 to IRQ0) (exiting software standby mode) | t_{IRQW} | 200 | — | 200 | — | 200 | — | ns | |

(3) Bus Timing

Table 25.33 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768$ kHz).

Table 25.33 Bus Timing

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7$ V to 5.5 V (mask ROM version), $V_{CC} = 3.0$ V to 5.5 V (F-ZTAT version),
 $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|----------------------------------|------------|---------------------------|-----|---------------------------|-----|---------------------------|-----|------|------------------------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| Address delay time | t_{AD} | — | 20 | — | 30 | — | 40 | ns | Figure 25.10 to figure 25.14 |
| Address setup time | t_{AS} | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | $0.5 \times t_{cyc} - 30$ | — | ns | |
| Address hold time | t_{AH} | $0.5 \times t_{cyc} - 10$ | — | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | ns | |
| \overline{CS} delay time (IOS) | t_{CSD} | — | 20 | — | 30 | — | 40 | ns | |
| \overline{AS} delay time | t_{ASD} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 1 | t_{RSD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 2 | t_{RSD2} | — | 30 | — | 45 | — | 60 | ns | |
| Read data setup time | t_{RDS} | 15 | — | 20 | — | 35 | — | ns | |
| Read data hold time | t_{RDH} | 0 | — | 0 | — | 0 | — | ns | |

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|-------------------------------|------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|------|------------------------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| Read data access time 1 | t_{ACC1} | — | $1.0 \times t_{cyc} - 30$ | — | $1.0 \times t_{cyc} - 40$ | — | $1.0 \times t_{cyc} - 60$ | ns | Figure 25.10 to figure 25.14 |
| Read data access time 2 | t_{ACC2} | — | $1.5 \times t_{cyc} - 25$ | — | $1.5 \times t_{cyc} - 35$ | — | $1.5 \times t_{cyc} - 50$ | ns | |
| Read data access time 3 | t_{ACC3} | — | $2.0 \times t_{cyc} - 30$ | — | $2.0 \times t_{cyc} - 40$ | — | $2.0 \times t_{cyc} - 60$ | ns | |
| Read data access time 4 | t_{ACC4} | — | $2.5 \times t_{cyc} - 25$ | — | $2.5 \times t_{cyc} - 35$ | — | $2.5 \times t_{cyc} - 50$ | ns | |
| Read data access time 5 | t_{ACC5} | — | $3.0 \times t_{cyc} - 30$ | — | $3.0 \times t_{cyc} - 40$ | — | $3.0 \times t_{cyc} - 60$ | ns | |
| \overline{WR} delay time 1 | t_{WRD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} delay time 2 | t_{WRD2} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} pulse width 1 | t_{WSW1} | $1.0 \times t_{cyc} - 20$ | — | $1.0 \times t_{cyc} - 30$ | — | $1.0 \times t_{cyc} - 40$ | — | ns | |
| \overline{WR} pulse width 2 | t_{WSW2} | $1.5 \times t_{cyc} - 20$ | — | $1.5 \times t_{cyc} - 30$ | — | $1.5 \times t_{cyc} - 40$ | — | ns | |
| Write data delay time | t_{WDD} | — | 30 | — | 45 | — | 60 | ns | |
| Write data setup time | t_{WDS} | 0 | — | 0 | — | 0 | — | ns | |
| Write data hold time | t_{WDH} | 10 | — | 15 | — | 20 | — | ns | |
| \overline{WAIT} setup time | t_{WTS} | 30 | — | 45 | — | 60 | — | ns | |
| \overline{WAIT} hold time | t_{WTH} | 5 | — | 5 | — | 10 | — | ns | |

(4) Timing of On-Chip Supporting Modules

Tables 25.34 shows the on-chip supporting module timing. The only on-chip supporting modules that can operate in subclock operation ($\phi = 32.768$ kHz) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 25.34 Timing of On-Chip Supporting Modules

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}^*$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}^*$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7\text{ V}$ to 5.5 V (mask ROM version), $V_{CC} = 3.0\text{ V}$ to 5.5 V (F-ZTAT version),
 $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}^*$, 2 MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|-----------|------------------------------|----------------------------|-----|-------------|-----|-------------|-----|------|-----------------|--------------|
| | | Min | Max | Min | Max | Min | Max | | | |
| I/O ports | Output data delay time | t_{PWD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.15 |
| | Input data setup time | t_{PRS} | 30 | — | 30 | — | 50 | — | | |
| | Input data hold time | t_{PRH} | 30 | — | 30 | — | 50 | — | | |
| FRT | Timer output delay time | t_{FTOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.16 |
| | Timer input setup time | t_{FTIS} | 30 | — | 30 | — | 50 | — | | |
| | Timer clock input setup time | t_{FTCS} | 30 | — | 30 | — | 50 | — | | Figure 25.17 |
| | Timer clock pulse width | Single edge t_{FTCWH} | 1.5 | — | 1.5 | — | 1.5 | — | t_{cyc} | |
| | Both edges t_{FTCWL} | 2.5 | — | 2.5 | — | 2.5 | — | | | |

| Item | | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | |
|---------------|--|--------------|-------------|-----|-------------|-----|-------------|-----|------------|-----------------|--------------|
| | | | 20 MHz | | 16 MHz | | 10 MHz | | | | |
| | | | Min | Max | Min | Max | Min | Max | | | |
| TMR | Timer output delay time | t_{TOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.18 | |
| | Timer reset input setup time | t_{TMS} | 30 | — | 30 | — | 50 | — | | Figure 25.20 | |
| | Timer clock input setup time | t_{TCS} | 30 | — | 30 | — | 50 | — | | Figure 25.19 | |
| | Timer clock pulse width | Single edge | t_{TMCWH} | 1.5 | — | 1.5 | — | 1.5 | — | t_{cyc} | |
| | | Both edges | t_{TMCWL} | 2.5 | — | 2.5 | — | 2.5 | — | | |
| PWM, PWMX | Pulse output delay time | t_{PWOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.21 | |
| SCI | Input clock cycle | Asynchronous | t_{Scyc} | 4 | — | 4 | — | 4 | — | t_{cyc} | Figure 25.22 |
| | | Synchronous | | 6 | — | 6 | — | 6 | — | | |
| | Input clock pulse width | t_{SCKW} | 0.4 | 0.6 | 0.4 | 0.6 | 0.4 | 0.6 | t_{Scyc} | | |
| | Input clock rise time | t_{SCKr} | — | 1.5 | — | 1.5 | — | 1.5 | t_{cyc} | | |
| | Input clock fall time | t_{SCKf} | — | 1.5 | — | 1.5 | — | 1.5 | | | |
| | Transmit data delay time (synchronous) | t_{TXD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.23 | |
| | Receive data setup time (synchronous) | t_{RXS} | 50 | — | 50 | — | 100 | — | ns | | |
| | Receive data hold time (synchronous) | t_{RXH} | 50 | — | 50 | — | 100 | — | ns | | |
| A/D converter | Trigger input setup time | t_{TRGS} | 30 | — | 30 | — | 50 | — | ns | Figure 25.24 | |

Note: * Only supporting modules that can be used in subclock operation.

25.4.4 A/D Conversion Characteristics

Tables 25.35 and 25.36 list the A/D conversion characteristics.

Table 25.35 A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $AV_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $AV_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C (mask ROM version):

$V_{CC} = 2.7\text{ V}$ to 5.5 V , $AV_{CC} = 2.7\text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

Condition C (F-ZTAT version):

$V_{CC} = 3.0\text{ V}$ to 5.5 V , $AV_{CC} = 3.0\text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0\text{ V}$, $\phi = 2\text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time*5 | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*3}}{5^{*4}}$ | — | — | $\frac{10^{*3}}{5^{*4}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | k Ω |
| Nonlinearity error | — | — | ± 3.0 | — | — | ± 3.0 | — | — | ± 7.0 | LSB |
| Offset error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Full-scale error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 4.0 | — | — | ± 4.0 | — | — | ± 8.0 | LSB |

Notes: 1. When $4.0\text{ V} \leq AV_{CC} \leq 5.5\text{ V}$

2. When $2.7\text{ V} \leq AV_{CC} < 4.0$ (mask ROM version) or when $3.0\text{ V} \leq AV_{CC} < 4.0\text{ V}$ (F-ZTAT version)

3. When conversion time $\geq 11.17\text{ }\mu\text{s}$ (CKS = 1 and $\phi \leq 12\text{ MHz}$, or CKS = 0)

4. When conversion time $< 11.17\text{ }\mu\text{s}$ (CKS = 1 and $\phi > 12\text{ MHz}$)

5. In single mode and $\phi =$ maximum operating frequency.

Table 25.36 A/D Conversion Characteristics
(CIN7 to CIN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C (mask ROM version):

$V_{CC} = 2.7 \text{ V}$ to 5.5 V , $AV_{CC} = 2.7 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

Condition C (F-ZTAT version):

$V_{CC} = 3.0 \text{ V}$ to 5.5 V , $AV_{CC} = 3.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time ^{*5} | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*3}}{5^{*4}}$ | — | — | $\frac{10^{*3}}{5^{*4}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | k Ω |
| Nonlinearity error | — | — | ± 5.0 | — | — | ± 5.0 | — | — | ± 11.0 | LSB |
| Offset error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Full-scale error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 6.0 | — | — | ± 6.0 | — | — | ± 12.0 | LSB |

Notes: 1. When $4.0 \text{ V} \leq AV_{CC} \leq 5.5 \text{ V}$

2. When $2.7 \text{ V} \leq AV_{CC} < 4.0$ (mask ROM version) or when $3.0 \text{ V} \leq AV_{CC} < 4.0 \text{ V}$ (F-ZTAT version)

3. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)

4. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)

5. In single mode and $\phi =$ maximum operating frequency.

25.4.5 D/A Conversion Characteristics

Table 25.37 lists the D/A conversion characteristics.

Table 25.37 D/A Conversion Characteristics

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C (mask ROM version):

$V_{CC} = 2.7 \text{ V}$ to 5.5 V , $AV_{CC} = 2.7 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

Condition C (F-ZTAT version):

$V_{CC} = 3.0 \text{ V}$ to 5.5 V , $AV_{CC} = 3.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------|-----------------------------------|-------------|-----------|-----------|-------------|-----------|-----------|-------------|-----------|-----------|---------------|
| | | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | Bits |
| Conversion time | With 20-pF load capacitance | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| Absolute accuracy | With 2-M Ω load resistance | — | ± 1.0 | ± 1.5 | — | ± 1.0 | ± 1.5 | — | ± 2.0 | ± 3.0 | LSB |
| | With 4-M Ω load resistance | — | — | ± 1.0 | — | — | ± 1.0 | — | — | ± 2.0 | |

25.4.6 Flash Memory Characteristics

Table 25.38 shows the flash memory characteristics.

Table 25.38 Flash Memory Characteristics

Conditions (5-V version): $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $T_a = 0\text{ to }+75^\circ\text{C}$ (regular specifications),
 $T_a = 0\text{ to }+85^\circ\text{C}$ (wide-range specifications)

(3-V version): $V_{CC} = 3.0\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = 0\text{ to }+75^\circ\text{C}$

| Item | Symbol | Min | Typ | Max | Unit | Test Condition | |
|--------------------------------------|--|---------------|-----|------|-------------|----------------|-----------------------|
| Programming time ^{*1 *2 *4} | tP | — | 10 | 200 | ms/32 bytes | | |
| Erase time ^{*1 *3 *6} | tE | — | 100 | 1200 | ms/block | | |
| Reprogramming count | N_{WEC} | — | — | 100 | Times | | |
| Programming | Wait time after SWE-bit setting ^{*1} | x | 10 | — | — | μs | |
| | Wait time after PSU-bit setting ^{*1} | y | 50 | — | — | μs | |
| | Wait time after P-bit setting ^{*1 *4} | z | 150 | — | 200 | μs | |
| | Wait time after P-bit clear ^{*1} | α | 10 | — | — | μs | |
| | Wait time after PSU-bit clear ^{*1} | β | 10 | — | — | μs | |
| | Wait time after PV-bit setting ^{*1} | γ | 4 | — | — | μs | |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs | |
| | Wait time after PV-bit clear ^{*1} | η | 4 | — | — | μs | |
| | Maximum programming count ^{*1 *4 *5} | N | — | — | 1000 | Times | z = 200 μs |
| Erase | Wait time after SWE-bit setting ^{*1} | x | 10 | — | — | μs | |
| | Wait time after ESU-bit setting ^{*1} | y | 200 | — | — | μs | |
| | Wait time after E-bit setting ^{*1 *6} | z | 5 | — | 10 | ms | |
| | Wait time after E-bit clear ^{*1} | α | 10 | — | — | μs | |
| | Wait time after ESU-bit clear ^{*1} | β | 10 | — | — | μs | |
| | Wait time after EV-bit setting ^{*1} | γ | 20 | — | — | μs | |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs | |
| | Wait time after EV-bit clear ^{*1} | η | 5 | — | — | μs | |
| | Maximum erase count ^{*1 *6 *7} | N | — | — | 120 | Times | z = 10 ms |

Notes: 1. Set the times according to the program/erase algorithms.

2. Programming time per 32 bytes (Shows the total period for which the P-bit in the flash memory control register (FLMCR1) is set. It does not include the programming verification time.)

3. Block erase time (shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
4. Maximum programming time (tP (max))
 $tP (\max) = \text{wait time after P-bit setting (z)} \times \text{maximum programming count (N)}$
5. Number of times when the wait time after P-bit setting (z) = 200 μ s.
 The number of writes should be set according to the actual set value of (z) to allow programming within the maximum programming time (tP (max)).
6. Maximum erase time (tE (max))
 $tE (\max) = \text{wait time after E-bit setting (z)} \times \text{maximum erase count (N)}$
7. Number of times when the wait time after E-bit setting (z) = 10 ms.
 The number of erases should be set according to the actual set value of (z) to allow erasing within the maximum erase time (tE (max)).

25.4.7 Usage Note

- (1) The F-ZTAT and mask ROM versions have been confirmed as fully meeting the reference values for electrical characteristics shown in this manual. However, actual performance figures, operating margins, noise margins, and other properties may vary due to differences in the manufacturing process, on-chip ROM, layout patterns, etc.

When system evaluation testing is carried out using the F-ZTAT version, the same evaluation tests should also be conducted for the mask ROM version when changing over to that version.

- (2) On-chip power supply step-down circuit

The following products do not incorporate an internal power supply step-down circuit: H8S/2134 F-ZTAT, H8S/2132 F-ZTAT, the mask ROM versions of the H8S/2132 and H8S/2130.

When changing over to F-ZTAT versions or mask ROM versions incorporating an internal step-down circuit, the VCC2 pin has the same pin location as the VCL pin in a step-down circuit (see figure 25.3).

Therefore, note that the circuit patterns differ between these two types of products.

25.5 Electrical Characteristics of H8S/2134 F-ZTAT (A-Mask Version), and Mask ROM Versions of H8S/2134 and H8S/2133

25.5.1 Absolute Maximum Ratings

Table 25.39 lists the absolute maximum ratings.

Table 25.39 Absolute Maximum Ratings

| Item | Symbol | Value | Unit |
|--|-----------|---|------|
| Power supply voltage*1 | V_{CC} | -0.3 to +7.0 | V |
| Power supply voltage*1 (3-V version) | V_{CC} | -0.3 to +4.3 | V |
| Power supply voltage*2 (VCL pin) | V_{CL} | -0.3 to +4.3 | V |
| Input voltage (except ports 6 and 7) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input not selected for port 6) | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| Input voltage (CIN input selected for port 6) | V_{in} | Lower voltage of -0.3 to $V_{CC} + 0.3$ and $AV_{CC} + 0.3$ | V |
| Input voltage (port 7) | V_{in} | -0.3 to $AV_{CC} + 0.3$ | V |
| Analog power supply voltage | AV_{CC} | -0.3 to +7.0 | V |
| Analog power supply voltage (3-V version) | AV_{CC} | -0.3 to +4.3 | V |
| Analog input voltage | V_{AN} | -0.3 to $AV_{CC} + 0.3$ | V |
| Operating temperature | T_{opr} | Regular specifications: -20 to +75 | °C |
| | | Wide-range specifications: -40 to +85 | °C |
| Operating temperature (flash memory programming/erasing) | T_{opr} | Regular specifications: -20 to +75 | °C |
| | | Wide-range specifications: -40 to +85 | °C |
| Storage temperature | T_{stg} | -55 to +125 | °C |

Caution: 1. Permanent damage to the chip may result if absolute maximum ratings are exceeded.

2. Never apply more than 7.0 V to any of the pins of the 5- or 4-V version or 4.3 V to any of the pins of the 3-V version.

Notes: 1. Voltage applied to the VCC1 pin.

Never exceed the maximum rating of V_{CL} in the low-power version (3-V version) because both the VCC1 and V_{CL} pins are connected to the V_{CC} power supply.

2. It is an operating power supply voltage pin on the chip.

Never apply power supply voltage to the V_{CL} pin in the 5- or 4-V version.

Always connect an external capacitor between the V_{CL} pin and ground for internal voltage stabilization.

25.5.2 DC Characteristics

Table 25.40 lists the DC characteristics. Table 25.41 lists the permissible output currents.

Table 25.40 DC Characteristics (1)

Conditions: $V_{CC} = 5.0\text{ V} \pm 10\%$, $AV_{CC}^{*1} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications), $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|---|-----------------|---------------------|-----|---------------------|---------------|---|
| Schmitt trigger input voltage | P67 to P60 (KWUL = 00) ^{*2 *4} , IRQ2 to IRQ0 ^{*3} , IRQ5 to IRQ3 | (1) V_T^- | 1.0 | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | |
| Input high voltage | \overline{RES} , \overline{STBY} , NMI, MD1, MD0 | (2) V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | EXTAL | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | Port 7 | | 2.0 | — | $AV_{CC} + 0.3$ | V | |
| | Input pins except (1) and (2) above | | 2.0 | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | \overline{RES} , \overline{STBY} , MD1, MD0 | (3) V_{IL} | -0.3 | — | 0.5 | V | |
| | NMI, EXTAL, input pins except (1) and (3) above | | -0.3 | — | 0.8 | V | |
| Output high voltage | All output pins | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200\ \mu\text{A}$ |
| | | | 3.5 | — | — | V | $I_{OH} = -1\ \text{mA}$ |
| Output low voltage | All output pins | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6\ \text{mA}$ |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 10\ \text{mA}$ |
| Input leakage current | \overline{RES} | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |
| | \overline{STBY} , NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }AV_{CC} - 0.5\text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|-------------------------------|-----------------------------|--------------|-----|------|------|---------------|---|
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 30 | — | 300 | μA | $V_{in} = 0\text{ V}$, $V_{CC} = 5\text{ V} \pm 10\%$ |
| | Port 6 | | 60 | — | 600 | μA | |
| Input capacitance | $\overline{\text{RES}}$ | (4) C_{in} | — | — | 80 | pF | $V_{in} = 0\text{ V}$, $f = 1\text{ MHz}$, $T_a = 25^\circ\text{C}$ |
| | NMI | | — | — | 50 | pF | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | |
| | Input pins except (4) above | | — | — | 15 | pF | |
| Current dissipation*5 | Normal operation | I_{CC} | — | 55 | 70 | mA | $f = 20\text{ MHz}$ |
| | Sleep mode | | — | 36 | 55 | mA | $f = 20\text{ MHz}$ |
| | Standby mode*6 | | — | 1.0 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0\text{ V to } 5.5\text{ V}$ |
| Analog power supply voltage*1 | | AV_{CC} | 4.5 | — | 5.5 | V | Operating |
| | | | 2.0 | — | 5.5 | V | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{CC}), or some other method.

- P67 to P60 include supporting module inputs multiplexed on those pins.
- $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.
- The upper limit of the port 6 applied voltage is $V_{CC} + 0.3\text{ V}$ when CIN input is not selected, and the lower of $V_{CC} + 0.3\text{ V}$ and $AV_{CC} + 0.3\text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- Current dissipation values are for $V_{IH} \text{ min} = V_{CC} - 0.2\text{ V}$ and $V_{IL} \text{ max} = 0.2\text{ V}$ with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- The values are for $V_{RAM} \leq V_{CC} < 4.5\text{ V}$, $V_{IH} \text{ min} = V_{CC} - 0.2\text{ V}$, and $V_{IL} \text{ max} = 0.2\text{ V}$.

Table 25.40 DC Characteristics (2)

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $AV_{CC}^{*1} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications), $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions | | |
|-------------------------------|--|--------|-----------------|---------------------|-----|---------------------|-----------------|--|---|
| Schmitt trigger input voltage | P67 to P60 ^{*2 *4} , $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}^{*3}$, $\overline{\text{IRQ5}}$ to $\overline{\text{IRQ3}}$ | (1) | V_T^- | 1.0 | — | — | V | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ | |
| | | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | | |
| | | | $V_T^+ - V_T^-$ | 0.4 | — | — | V | | |
| | | | V_T^- | 0.8 | — | — | V | | $V_{CC} < 4.5\text{ V}$ |
| | | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | | |
| Input high voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, NMI, MD1, MD0 | (2) | V_{IH} | $V_{CC} - 0.7$ | — | $V_{CC} + 0.3$ | V | | |
| | | | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | | |
| | | | | 2.0 | — | $AV_{CC} + 0.3$ | V | | |
| | | | | 2.0 | — | $V_{CC} + 0.3$ | V | | |
| Input low voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, MD1, MD0 | (3) | V_{IL} | -0.3 | — | 0.5 | V | | |
| | | | | -0.3 | — | 0.8 | V | | |
| Output high voltage | All output pins | | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200\ \mu\text{A}$ | |
| | | | | 3.5 | — | — | V | | $I_{OH} = -1\ \text{mA}$, $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ |
| | | | | 3.0 | — | — | V | | $I_{OH} = -1\ \text{mA}$, $V_{CC} < 4.5\text{ V}$ |
| Output low voltage | All output pins | | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6\ \text{mA}$ | |
| | | | | Ports 1 to 3 | — | — | 1.0 | V | $I_{OL} = 10\ \text{mA}$ |
| Input leakage current | $\overline{\text{RES}}$ | | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ | |
| | $\overline{\text{STBY}}$, NMI, MD1, MD0 | | | — | — | 1.0 | μA | | |
| | Port 7 | | | — | — | 1.0 | μA | | $V_{in} = 0.5\text{ to }AV_{CC} - 0.5\text{ V}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|---|-----------------------------|-------------|-----|------|-----|---------------|---|-----------------------------|
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5$ to $V_{CC} - 0.5$ V | |
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 30 | — | 300 | μA | $V_{in} = 0$ V, $V_{CC} = 4.5$ V to 5.5 V | |
| | Port 6 | | 60 | — | 600 | μA | | |
| | Ports 1 to 3 | | 20 | — | 200 | μA | $V_{in} = 0$ V, $V_{CC} < 4.5$ V | |
| | Port 6 | | 40 | — | 500 | μA | | |
| Input capacitance | \overline{RES} (4) | C_{in} | — | — | 80 | pF | $V_{in} = 0$ V, $f = 1$ MHz, $T_a = 25^\circ\text{C}$ | |
| | NMI | | — | — | 50 | pF | | |
| | P52, P97, P42, P86 | | — | — | 20 | pF | | |
| | Input pins except (4) above | | — | — | 15 | pF | | |
| Current dissipation ^{*5} | Normal operation | I_{CC} | — | 45 | 58 | mA | $f = 16$ MHz | |
| | Sleep mode | | — | 30 | 46 | mA | $f = 16$ MHz | |
| | Standby mode ^{*6} | | | — | 1.0 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | AI_{CC} | — | 3.2 | 7.0 | mA | | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{CC} = 2.0$ V to 5.5 V | |
| Analog power supply voltage ^{*1} | | AV_{CC} | 4.0 | — | 5.5 | V | Operating | |
| | | | 2.0 | — | 5.5 | V | Idle/not used | |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{CC}), or some other method.

- P67 to P60 include supporting module inputs multiplexed on those pins.
- IRQ2 includes the ADTRG signal multiplexed on that pin.
- The upper limit of the port 6 applied voltage is $V_{CC} + 0.3$ V when CIN input is not selected, and the lower of $V_{CC} + 0.3$ V and $AV_{CC} + 0.3$ V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- Current dissipation values are for V_{IH} min = $V_{CC} - 0.2$ V and V_{IL} max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- The values are for $V_{RAM} \leq V_{CC} < 4.0$ V, V_{IH} min = $V_{CC} - 0.2$ V, and V_{IL} max = 0.2 V.

Table 25.40 DC Characteristics (3)

Conditions: $V_{CC} = 2.7\text{ V to }3.6\text{ V}^{*5}$, $AV_{CC}^{*1} = 2.7\text{ V to }3.6\text{ V}$, $V_{SS} = AV_{SS}^{*1} = 0\text{ V}$,
 $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|--|-----------------|----------------------|-----|---------------------|---------------|---|
| Schmitt trigger input voltage | P67 to P60 ^{*2 *4} , (1) $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}^{*3}$, $\overline{\text{IRQ5}}$ to $\overline{\text{IRQ3}}$ | V_T^- | $V_{CC} \times 0.2$ | — | — | V | |
| | | V_T^+ | — | — | $V_{CC} \times 0.7$ | V | |
| | | $V_T^+ - V_T^-$ | $V_{CC} \times 0.05$ | — | — | V | |
| Input high voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, (2) NMI, MD1, MD0 | V_{IH} | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | EXTAL | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| | Port 7 | | $V_{CC} \times 0.7$ | — | $AV_{CC} + 0.3$ | V | |
| | Input pins except (1) and (2) above | | $V_{CC} \times 0.7$ | — | $V_{CC} + 0.3$ | V | |
| Input low voltage | $\overline{\text{RES}}$, $\overline{\text{STBY}}$, (3) MD1, MD0 | V_{IL} | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | NMI, EXTAL, input pins except (1) and (3) above | | -0.3 | — | $V_{CC} \times 0.2$ | V | |
| Output high voltage | All output pins | V_{OH} | $V_{CC} - 0.5$ | — | — | V | $I_{OH} = -200\ \mu\text{A}$ |
| | | | $V_{CC} - 1.0$ | — | — | V | $I_{OH} = -1\ \text{mA}$ |
| Output low voltage | All output pins | V_{OL} | — | — | 0.4 | V | $I_{OL} = 1.6\ \text{mA}$ |
| | Ports 1 to 3 | | — | — | 1.0 | V | $I_{OL} = 5\ \text{mA}$ |
| Input leakage current | $\overline{\text{RES}}$ | $ I_{in} $ | — | — | 10.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |
| | $\overline{\text{STBY}}$, NMI, MD1, MD0 | | — | — | 1.0 | μA | |
| | Port 7 | | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }AV_{CC} - 0.5\text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9 | $ I_{TSI} $ | — | — | 1.0 | μA | $V_{in} = 0.5\text{ to }V_{CC} - 0.5\text{ V}$ |

| Item | | Symbol | Min | Typ | Max | Unit | Test Conditions |
|---|-----------------------------|------------|-----|------|------|---------------|--|
| Input pull-up MOS current | Ports 1 to 3 | $-I_P$ | 5 | — | 150 | μA | $V_{in} = 0\text{ V}$, |
| | Port 6 | | 30 | — | 300 | μA | $V_{cc} = 2.7\text{ V}$ to 3.6 V |
| Input capacitance | $\overline{\text{RES}}$ (4) | C_{in} | — | — | 80 | pF | $V_{in} = 0\text{ V}$, |
| | NMI | | — | — | 50 | pF | $f = 1\text{ MHz}$, |
| | P52, P97, P42, P86 | | — | — | 20 | pF | $T_a = 25^\circ\text{C}$ |
| | Input pins except (4) above | | — | — | 15 | pF | |
| Current dissipation ^{*6} | Normal operation | I_{cc} | — | 30 | 40 | mA | $f = 10\text{ MHz}$ |
| | Sleep mode | | — | 20 | 32 | mA | $f = 10\text{ MHz}$ |
| | Standby mode ^{*7} | | — | 1.0 | 5.0 | μA | $T_a \leq 50^\circ\text{C}$ |
| | | | — | — | 20.0 | μA | $50^\circ\text{C} < T_a$ |
| Analog power supply current | During A/D, D/A conversion | $A I_{cc}$ | — | 3.2 | 7.0 | mA | |
| | Idle | | — | 0.01 | 5.0 | μA | $AV_{cc} = 2.0\text{ V}$ to 3.6 V |
| Analog power supply voltage ^{*1} | | AV_{cc} | 2.7 | — | 3.6 | V | Operating |
| | | | 2.0 | — | 3.6 | V | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | — | — | V | |

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AVCC by connection to the power supply (V_{cc}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.
3. $\overline{\text{IRQ2}}$ includes the $\overline{\text{ADTRG}}$ signal multiplexed on that pin.
4. The upper limit of the port 6 applied voltage is $V_{cc} + 0.3\text{ V}$ when CIN input is not selected, and the lower of $V_{cc} + 0.3\text{ V}$ and $AV_{cc} + 0.3\text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
5. For flash memory program/erase operations, the applicable range is $V_{cc} = 3.0\text{ V}$ to 3.6 V .
6. Current dissipation values are for $V_{IH} \text{ min} = V_{cc} - 0.2\text{ V}$ and $V_{IL} \text{ max} = 0.2\text{ V}$ with all output pins unloaded and the on-chip pull-up MOSs in the off state.
7. The values are for $V_{RAM} \leq V_{cc} < 2.7\text{ V}$, $V_{IH} \text{ min} = V_{cc} - 0.2\text{ V}$, and $V_{IL} \text{ max} = 0.2\text{ V}$.

Table 25.41 Permissible Output Currents

Conditions: $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications),
 $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | Ports 1, 2, 3 | I_{OL} | — | — | 10 | mA |
| | Other output pins | | — | — | 2 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 80 | mA |
| | Total of all output pins, including the above | | — | — | 120 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | — | — | 40 | mA |

Conditions: $V_{CC} = 2.7\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | | Symbol | Min | Typ | Max | Unit |
|---|---|----------------|-----|-----|-----|------|
| Permissible output low current (per pin) | Ports 1, 2, 3 | I_{OL} | — | — | 2 | mA |
| | Other output pins | | — | — | 1 | mA |
| Permissible output low current (total) | Total of ports 1 to 3 | $\sum I_{OL}$ | — | — | 40 | mA |
| | Total of all output pins, including the above | | — | — | 60 | mA |
| Permissible output high current (per pin) | All output pins | $-I_{OH}$ | — | — | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | — | — | 30 | mA |

- Notes: 1. To protect chip reliability, do not exceed the output current values in table 25.41.
 2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 25.1 and 25.2.

25.5.3 AC Characteristics

Clock timing, control signal timing, bus timing, and timing of on-chip supporting modules list the following.

Figure 25.4 shows the test conditions for the AC characteristics.

(1) Clock Timing

Table 25.42 shows the clock timing. The clock timing specified here covers clock (ϕ) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details of external clock input (EXTAL pin and EXCL pin) timing, see section 23, Clock Pulse Generator.

Table 25.42 Clock Timing

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 3.6 V , $V_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|---|-------------------|-------------|-----|-------------|-----|-------------|-----|---------------|----------------------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| Clock cycle time | t_{cyc} | 50 | 500 | 62.5 | 500 | 100 | 500 | ns | Figure 25.5 |
| Clock high pulse width | t_{CH} | 17 | — | 20 | — | 30 | — | ns | |
| Clock low pulse width | t_{CL} | 17 | — | 20 | — | 30 | — | ns | |
| Clock rise time | t_{Cr} | — | 8 | — | 10 | — | 20 | ns | |
| Clock fall time | t_{Cf} | — | 8 | — | 10 | — | 20 | ns | |
| Oscillation settling time at reset (crystal) | t_{OSC1} | 10 | — | 10 | — | 20 | — | ms | Figure 25.6 Figure 25.7 |
| Oscillation settling time in software standby (crystal) | t_{OSC2} | 8 | — | 8 | — | 8 | — | ms | |
| External clock output stabilization delay time | t_{DEXT} | 500 | — | 500 | — | 500 | — | μs | |

(2) Control Signal Timing

Table 25.43 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768$ kHz) are NMI and IRQ0, IRQ1, IRQ2, IRQ6, and IRQ7.

Table 25.43 Control Signal Timing

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7\text{ V}$ to 3.6 V , $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|--|-------------------|-------------|-----|-------------|-----|-------------|-----|------------------|-----------------|
| | | Min | Max | Min | Max | Min | Max | | |
| $\overline{\text{RES}}$ setup time | t_{RESS} | 200 | — | 200 | — | 300 | — | ns | Figure 25.8 |
| $\overline{\text{RES}}$ pulse width | t_{RESW} | 20 | — | 20 | — | 20 | — | t_{cyc} | |
| NMI setup time (NMI) | t_{NMIS} | 150 | — | 150 | — | 250 | — | ns | Figure 25.9 |
| NMI hold time (NMI) | t_{NMIH} | 10 | — | 10 | — | 10 | — | | |
| NMI pulse width (exiting software standby mode) | t_{NMIW} | 200 | — | 200 | — | 200 | — | ns | |
| IRQ setup time (IRQ7 to $\overline{\text{IRQ0}}$) | t_{IRQS} | 150 | — | 150 | — | 250 | — | ns | |
| IRQ hold time (IRQ7 to $\overline{\text{IRQ0}}$) | t_{IRQH} | 10 | — | 10 | — | 10 | — | ns | |
| IRQ pulse width ($\overline{\text{IRQ7}}$, $\overline{\text{IRQ6}}$, $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}$) (exiting software standby mode) | t_{IRQW} | 200 | — | 200 | — | 200 | — | ns | |

(3) Bus Timing

Table 25.44 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768$ kHz).

Table 25.44 Bus Timing

Condition A: $V_{CC} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0$ V to 5.5 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7$ V to 3.6 V, $V_{SS} = 0$ V, $\phi = 2$ MHz to maximum operating frequency,
 $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|----------------------------------|------------|---------------------------|-----|---------------------------|-----|---------------------------|-----|------|------------------------------|
| | | 20 MHz | Max | 16 MHz | Max | 10 MHz | Max | | |
| Address delay time | t_{AD} | — | 20 | — | 30 | — | 40 | ns | Figure 25.10 to figure 25.14 |
| Address setup time | t_{AS} | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | $0.5 \times t_{cyc} - 30$ | — | ns | |
| Address hold time | t_{AH} | $0.5 \times t_{cyc} - 10$ | — | $0.5 \times t_{cyc} - 15$ | — | $0.5 \times t_{cyc} - 20$ | — | ns | |
| \overline{CS} delay time (IOS) | t_{CSD} | — | 20 | — | 30 | — | 40 | ns | |
| \overline{AS} delay time | t_{ASD} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 1 | t_{RSD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{RD} delay time 2 | t_{RSD2} | — | 30 | — | 45 | — | 60 | ns | |
| Read data setup time | t_{RDS} | 15 | — | 20 | — | 35 | — | ns | |
| Read data hold time | t_{RDH} | 0 | — | 0 | — | 0 | — | ns | |

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions |
|-------------------------------|------------|-------------------------------|-------------------------------|-------------------------------|-------------------------------|-------------------------------|-------------------------------|------|------------------------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| Read data access time 1 | t_{ACC1} | — | $1.0 \times$ $t_{cyc} -30$ | — | $1.0 \times$ $t_{cyc} -40$ | — | $1.0 \times$ $t_{cyc} -60$ | ns | Figure 25.10 to figure 25.14 |
| Read data access time 2 | t_{ACC2} | — | $1.5 \times$ $t_{cyc} -25$ | — | $1.5 \times$ $t_{cyc} -35$ | — | $1.5 \times$ $t_{cyc} -50$ | ns | |
| Read data access time 3 | t_{ACC3} | — | $2.0 \times$ $t_{cyc} -30$ | — | $2.0 \times$ $t_{cyc} -40$ | — | $2.0 \times$ $t_{cyc} -60$ | ns | |
| Read data access time 4 | t_{ACC4} | — | $2.5 \times$ $t_{cyc} -25$ | — | $2.5 \times$ $t_{cyc} -35$ | — | $2.5 \times$ $t_{cyc} -50$ | ns | |
| Read data access time 5 | t_{ACC5} | — | $3.0 \times$ $t_{cyc} -30$ | — | $3.0 \times$ $t_{cyc} -40$ | — | $3.0 \times$ $t_{cyc} -60$ | ns | |
| \overline{WR} delay time 1 | t_{WRD1} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} delay time 2 | t_{WRD2} | — | 30 | — | 45 | — | 60 | ns | |
| \overline{WR} pulse width 1 | t_{WSW1} | $1.0 \times$ $t_{cyc} -20$ | — | $1.0 \times$ $t_{cyc} -30$ | — | $1.0 \times$ $t_{cyc} -40$ | — | ns | |
| \overline{WR} pulse width 2 | t_{WSW2} | $1.5 \times$ $t_{cyc} -20$ | — | $1.5 \times$ $t_{cyc} -30$ | — | $1.5 \times$ $t_{cyc} -40$ | — | ns | |
| Write data delay time | t_{WDD} | — | 30 | — | 45 | — | 60 | ns | |
| Write data setup time | t_{WDS} | 0 | — | 0 | — | 0 | — | ns | |
| Write data hold time | t_{WDH} | 10 | — | 15 | — | 20 | — | ns | |
| \overline{WAIT} setup time | t_{WTS} | 30 | — | 45 | — | 60 | — | ns | |
| \overline{WAIT} hold time | t_{WTH} | 5 | — | 5 | — | 10 | — | ns | |

(4) Timing of On-Chip Supporting Modules

Table 25.45 shows the on-chip supporting module timing. The only on-chip supporting modules that can operate in subclock operation ($\phi = 32.768$ kHz) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 25.45 Timing of On-Chip Supporting Modules

Condition A: $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}^*$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}^*$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7\text{ V}$ to 3.6 V , $V_{SS} = 0\text{ V}$, $\phi = 32.768\text{ kHz}^*$, 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | | |
|-----------|------------------------------|----------------------------|-----|-------------|-----|-------------|-----|------|-----------------|--------------|--------------|
| | | Min | Max | Min | Max | Min | Max | | | | |
| I/O ports | Output data delay time | t_{PVD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.15 | |
| | Input data setup time | t_{PRS} | 30 | — | 30 | — | 50 | — | | | |
| | Input data hold time | t_{PRH} | 30 | — | 30 | — | 50 | — | | | |
| FRT | Timer output delay time | t_{FTOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.16 | |
| | Timer input setup time | t_{FTIS} | 30 | — | 30 | — | 50 | — | | | |
| | Timer clock input setup time | t_{FTCS} | 30 | — | 30 | — | 50 | — | | | Figure 25.17 |
| | Timer clock pulse width | Single edge t_{FTCWH} | 1.5 | — | 1.5 | — | 1.5 | — | | | |
| | Both edges t_{FTCWL} | 2.5 | — | 2.5 | — | 2.5 | — | | | | |

| Item | Symbol | Condition A | | Condition B | | Condition C | | Unit | Test Conditions | | |
|---------------------------------------|--|---------------------------|----------------------------|-------------|-----|-------------|-----|------------|-----------------|--------------|--------------|
| | | 20 MHz | | 16 MHz | | 10 MHz | | | | | |
| | | Min | Max | Min | Max | Min | Max | | | | |
| TMR | Timer output delay time | t_{TMOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.18 | |
| | Timer reset input setup time | t_{TMRS} | 30 | — | 30 | — | 50 | — | | Figure 25.20 | |
| | Timer clock input setup time | t_{TMCS} | 30 | — | 30 | — | 50 | — | | Figure 25.19 | |
| | Timer clock pulse width | Single edge Both edges | t_{TMCWH} t_{TMCWL} | 1.5 2.5 | — | 1.5 2.5 | — | 1.5 2.5 | — | t_{cyc} | |
| PWMX | Pulse output delay time | t_{PWOD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.21 | |
| SCI | Input clock cycle | Asynchronous | t_{Syc} | 4 | — | 4 | — | 4 | — | t_{cyc} | Figure 25.22 |
| | | Synchronous | | 6 | — | 6 | — | 6 | — | | |
| | Input clock pulse width | t_{SCKW} | 0.4 | 0.6 | 0.4 | 0.6 | 0.4 | 0.6 | t_{Syc} | | |
| | Input clock rise time | t_{SCKr} | — | 1.5 | — | 1.5 | — | 1.5 | t_{cyc} | | |
| | Input clock fall time | t_{SCKf} | — | 1.5 | — | 1.5 | — | 1.5 | | | |
| | Transmit data delay time (synchronous) | t_{TXD} | — | 50 | — | 50 | — | 100 | ns | Figure 25.23 | |
| Receive data setup time (synchronous) | t_{RXS} | 50 | — | 50 | — | 100 | — | ns | | | |
| Receive data hold time (synchronous) | t_{RXH} | 50 | — | 50 | — | 100 | — | ns | | | |
| A/D converter | Trigger input setup time | t_{TRGS} | 30 | — | 30 | — | 50 | — | ns | Figure 25.24 | |

Note: * Only supporting modules that can be used in subclock operation.

25.5.4 A/D Conversion Characteristics

Tables 25.46 and 25.47 list the A/D conversion characteristics.

Table 25.46 A/D Conversion Characteristics
(AN7 to AN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 3.6 V , $AV_{CC} = 2.7 \text{ V}$ to 3.6 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|-----------|------------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time ^{*3} | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | 5 | $\text{k}\Omega$ |
| Nonlinearity error | — | — | ± 3.0 | — | — | ± 3.0 | — | — | ± 7.0 | LSB |
| Offset error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Full-scale error | — | — | ± 3.5 | — | — | ± 3.5 | — | — | ± 7.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 4.0 | — | — | ± 4.0 | — | — | ± 8.0 | LSB |

Notes: 1. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)

2. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)

3. In single mode and $\phi =$ maximum operating frequency.

Table 25.47 A/D Conversion Characteristics
(CIN7 to CIN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 3.0 \text{ V}$ to 3.6 V^{*4} , $AV_{CC} = 3.0 \text{ V}$ to 3.6 V^{*4} , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------------------------|-------------|-----|--------------------------|-------------|-----|--------------------------|-------------|-----|------------|---------------|
| | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 | Bits |
| Conversion time ^{*3} | — | — | 6.7 | — | — | 8.4 | — | — | 13.4 | μs |
| Analog input capacitance | — | — | 20 | — | — | 20 | — | — | 20 | pF |
| Permissible signal-source impedance | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | $\frac{10^{*1}}{5^{*2}}$ | — | — | 5 | k Ω |
| Nonlinearity error | — | — | ± 5.0 | — | — | ± 5.0 | — | — | ± 11.0 | LSB |
| Offset error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Full-scale error | — | — | ± 5.5 | — | — | ± 5.5 | — | — | ± 11.5 | LSB |
| Quantization error | — | — | ± 0.5 | — | — | ± 0.5 | — | — | ± 0.5 | LSB |
| Absolute accuracy | — | — | ± 6.0 | — | — | ± 6.0 | — | — | ± 12.0 | LSB |

- Notes: 1. When conversion time $\geq 11.17 \mu\text{s}$ (CKS = 1 and $\phi \leq 12 \text{ MHz}$, or CKS = 0)
2. When conversion time $< 11.17 \mu\text{s}$ (CKS = 1 and $\phi > 12 \text{ MHz}$)
3. In single mode and $\phi =$ maximum operating frequency.
4. When using CIN, the applicable range is $V_{CC} = 3.0 \text{ V}$ to 3.6 V and $AV_{CC} = 3.0 \text{ V}$ to 3.6 V .

25.5.5 D/A Conversion Characteristics

Table 25.48 lists the D/A conversion characteristics.

Table 25.48 D/A Conversion Characteristics

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V , $AV_{CC} = 4.0 \text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40$ to $+85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 2.7 \text{ V}$ to 3.6 V , $AV_{CC} = 2.7 \text{ V}$ to 3.6 V , $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20$ to $+75^\circ\text{C}$

| Item | | Condition A | | | Condition B | | | Condition C | | | Unit |
|-------------------|-----------------------------------|-------------|-----------|-----------|-------------|-----------|-----------|-------------|-----------|-----------|---------------|
| | | 20 MHz | | | 16 MHz | | | 10 MHz | | | |
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Resolution | | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | Bits |
| Conversion time | With 20 pF load capacitance | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| Absolute accuracy | With 2 M Ω load resistance | — | ± 1.0 | ± 1.5 | — | ± 1.0 | ± 1.5 | — | ± 2.0 | ± 3.0 | LSB |
| | With 4 M Ω load resistance | — | — | ± 1.0 | — | — | ± 1.0 | — | — | ± 2.0 | |

25.5.6 Flash Memory Characteristics

Table 25.49 shows the flash memory characteristics.

Table 25.49 Flash Memory Characteristics (Programming/Erasing Operating Range)

Conditions (5-V version): $V_{CC} = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$ (regular specifications), $T_a = -40\text{ to }+85^\circ\text{C}$ (wide-range specifications)

(3-V version): $V_{CC} = 3.0\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -20\text{ to }+75^\circ\text{C}$

| Item | Symbol | Min | Typ | Max | Unit | Test Condition | |
|--|--|---|---------------------|------|------------------|----------------|--------------------|
| Programming time ^{*1 *2 *4} | tP | — | 10 | 200 | ms/ 128 bytes | | |
| Erase time ^{*1 *3 *6} | tE | — | 100 | 1200 | ms/block | | |
| Reprogramming count | N_{WEC} | 100 ^{*8} | 10000 ^{*9} | — | Times | | |
| Data retention time ^{*10} | t_{DRP} | 10 | — | — | Years | | |
| Programming | Wait time after SWE-bit setting ^{*1} | x | 1 | — | — | μs | |
| | Wait time after PSU-bit setting ^{*1} | y | 50 | — | — | μs | |
| | Wait time after P-bit setting ^{*1 *4} | z1 | 28 | 30 | 32 | μs | 1 ≤ n ≤ 6 |
| | | z2 | 198 | 200 | 202 | μs | 7 ≤ n ≤ 1000 |
| | | z3 | 8 | 10 | 12 | μs | Additional writing |
| | Wait time after P-bit clear ^{*1} | α | 5 | — | — | μs | |
| | Wait time after PSU-bit clear ^{*1} | β | 5 | — | — | μs | |
| | Wait time after PV-bit setting ^{*1} | γ | 4 | — | — | μs | |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs | |
| | Wait time after PV-bit clear ^{*1} | η | 4 | — | — | μs | |
| | Wait time after SWE-bit clear ^{*1} | θ | 100 | — | — | μs | |
| | Maximum programming count ^{*1 *4 *5} | N | — | — | 1000 | Times | |
| | Erase | Wait time after SWE-bit setting ^{*1} | x | 1 | — | — | μs |
| Wait time after ESU-bit setting ^{*1} | | y | 100 | — | — | μs | |
| Wait time after E-bit setting ^{*1 *6} | | z | 10 | — | 100 | ms | |
| Wait time after E-bit clear ^{*1} | | α | 10 | — | — | μs | |
| Wait time after ESU-bit clear ^{*1} | | β | 10 | — | — | μs | |
| Wait time after EV-bit setting ^{*1} | | γ | 20 | — | — | μs | |
| Wait time after dummy write ^{*1} | | ε | 2 | — | — | μs | |
| Wait time after EV-bit clear ^{*1} | | η | 4 | — | — | μs | |
| Wait time after SWE-bit clear ^{*1} | | θ | 100 | — | — | μs | |
| Maximum erase count ^{*1 *6 *7} | | N | — | — | 120 | Times | |

- Notes:
1. Set the times according to the program/erase algorithms.
 2. Programming time per 128 bytes (Shows the total period for which the P-bit in the flash memory control register (FLMCR1) is set. It does not include the programming verification time.)
 3. Block erase time (shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
 4. Maximum programming time (tP (max))
$$tP \text{ (max)} = (\text{wait time after P-bit setting (z1)} + (\text{z3}) \times 6 + \text{wait time after P-bit setting (z2)}) \times ((N) - 6)$$
 5. Maximum programming count (N) should be set according to the actual set value of (z1, z2, z3) to allow programming within the maximum programming time (tP (max)). The wait time after P-bit setting (z1, z2, z3) must be changed with the value of the number of writing times (n) as follows.
The number of times for writing n
$$1 \leq n \leq 6 \quad z1 = 30 \mu\text{s}, z3 = 10 \mu\text{s}$$
$$7 \leq n \leq 1000 \quad z2 = 200 \mu\text{s}$$
 6. Maximum erase time (tE (max))
$$tE \text{ (max)} = \text{waiting time after E-bit setting (z)} \times \text{Maximum erase count (N)}$$
 7. Maximum erase count (N) should be set according to the actual setting (z) to allow erase within the maximum erase time (tE (max)).
 8. Minimum number of times for which all characteristics are guaranteed after rewriting (Guarantee range is 1 to minimum value).
 9. Reference value for 25°C (as a guideline, rewriting should normally function up to this value).
 10. Data retention characteristic when rewriting is performed within the specification range, including the minimum value.

25.5.7 Usage Note

- (1) The F-ZTAT and mask ROM versions have been confirmed as fully meeting the reference values for electrical characteristics shown in this manual. However, actual performance figures, operating margins, noise margins, and other properties may vary due to differences in the manufacturing process, on-chip ROM, layout patterns, etc.

When system evaluation testing is carried out using the F-ZTAT version, the same evaluation tests should also be conducted for the mask ROM version when changing over to that version.

- (2) On-chip power supply step-down circuit

The following products incorporate an internal power supply step-down circuit, which automatically drops down the internal power supply voltage to the optimum internal voltage level: the F-ZTAT A-mask version of the H8S/2134 (HD64F2134A) and the mask ROM versions of the H8S/2134, and H8S/2133 (HD6432134S, and HD6432133S).

The voltage-stabilization capacitor (0.47 μ F one or two connected in series) must be connected between the VCL (internal power supply step-down) and V_{SS} pins.

Figure 25.3 shows the connection of the external capacitors.

For the 5- or 4-V version, do not connect the VCL pin in a product incorporating an internal step-down circuit to the V_{CC} power supply. (Connect the VCC1 pin to the V_{CC} power supply as usual.) For the 3-V version, connect both the VCL and VCC1 pins to the system power supply. When changing from the F-ZTAT versions not incorporating an internal step-down circuit to the mask ROM versions incorporating an internal step-down circuit, the VCL pin has the same pin location as the VCC2 pin.

Therefore, note that the circuit patterns differ between these two types of products.

25.6 Operational Timing

This section shows timing diagrams.

Figure 25.4 shows the test conditions for the AC characteristics.

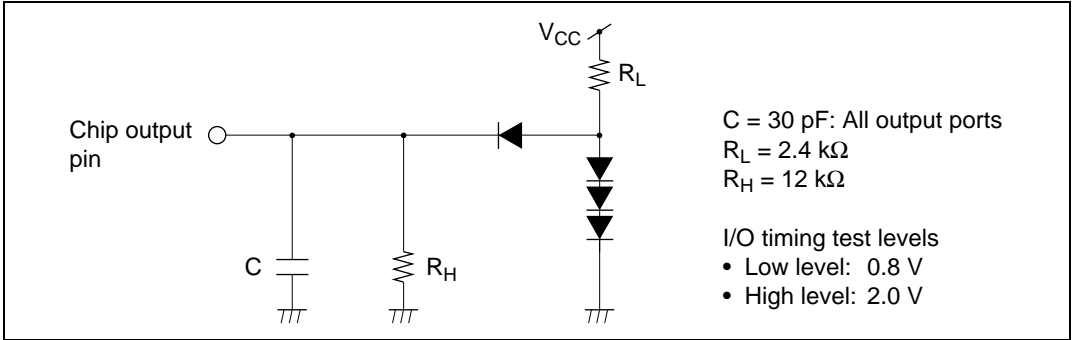


Figure 25.4 Output Load Circuit

25.6.1 Clock Timing

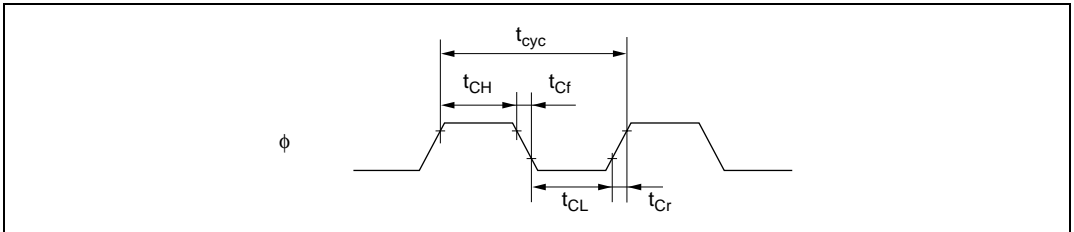


Figure 25.5 System Clock Timing

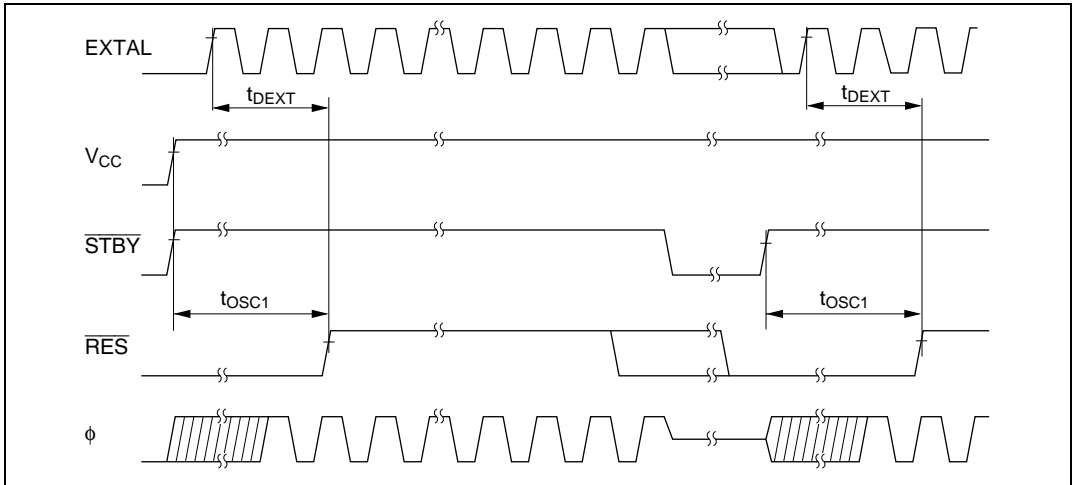


Figure 25.6 Oscillation Settling Timing

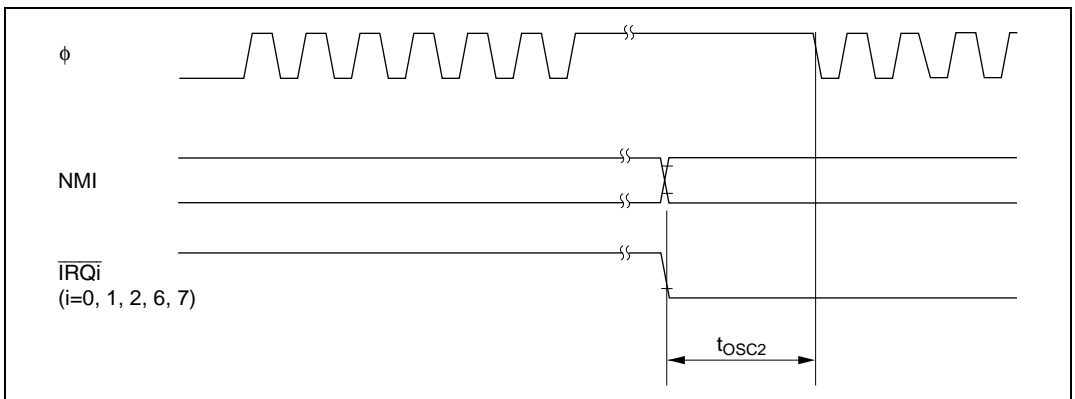


Figure 25.7 Oscillation Setting Timing (Exiting Software Standby Mode)

25.6.2 Control Signal Timing

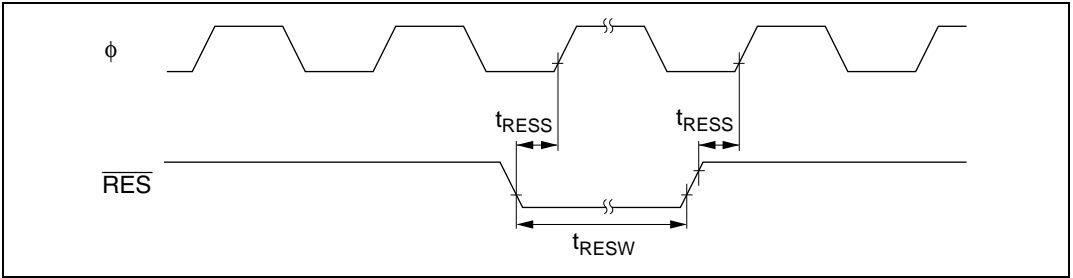


Figure 25.8 Reset Input Timing

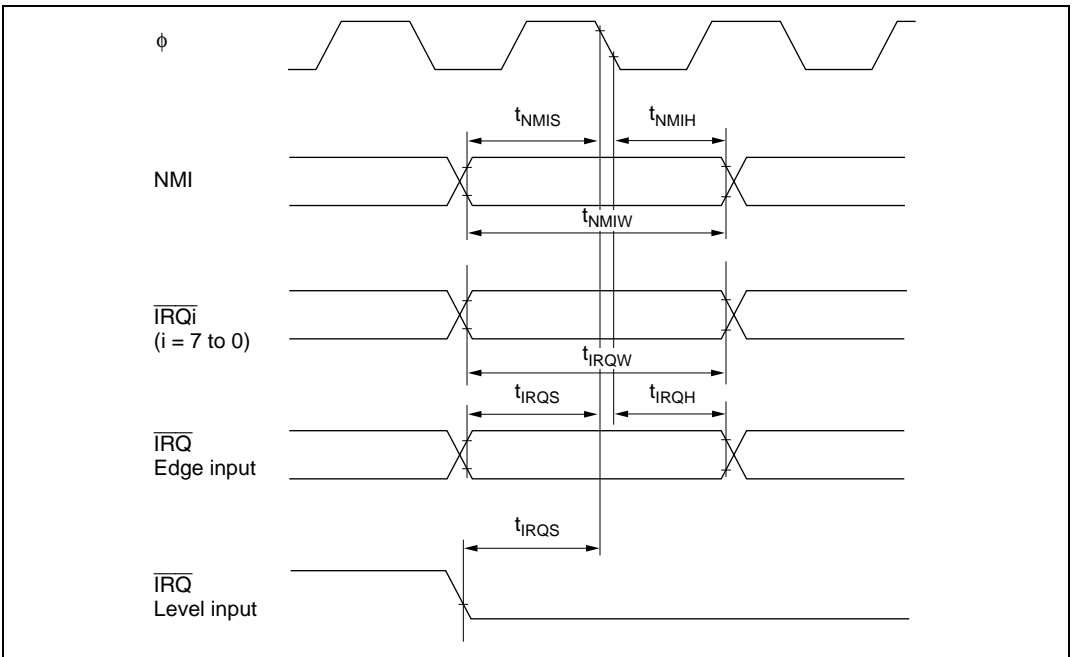


Figure 25.9 Interrupt Input Timing

25.6.3 Bus Timing

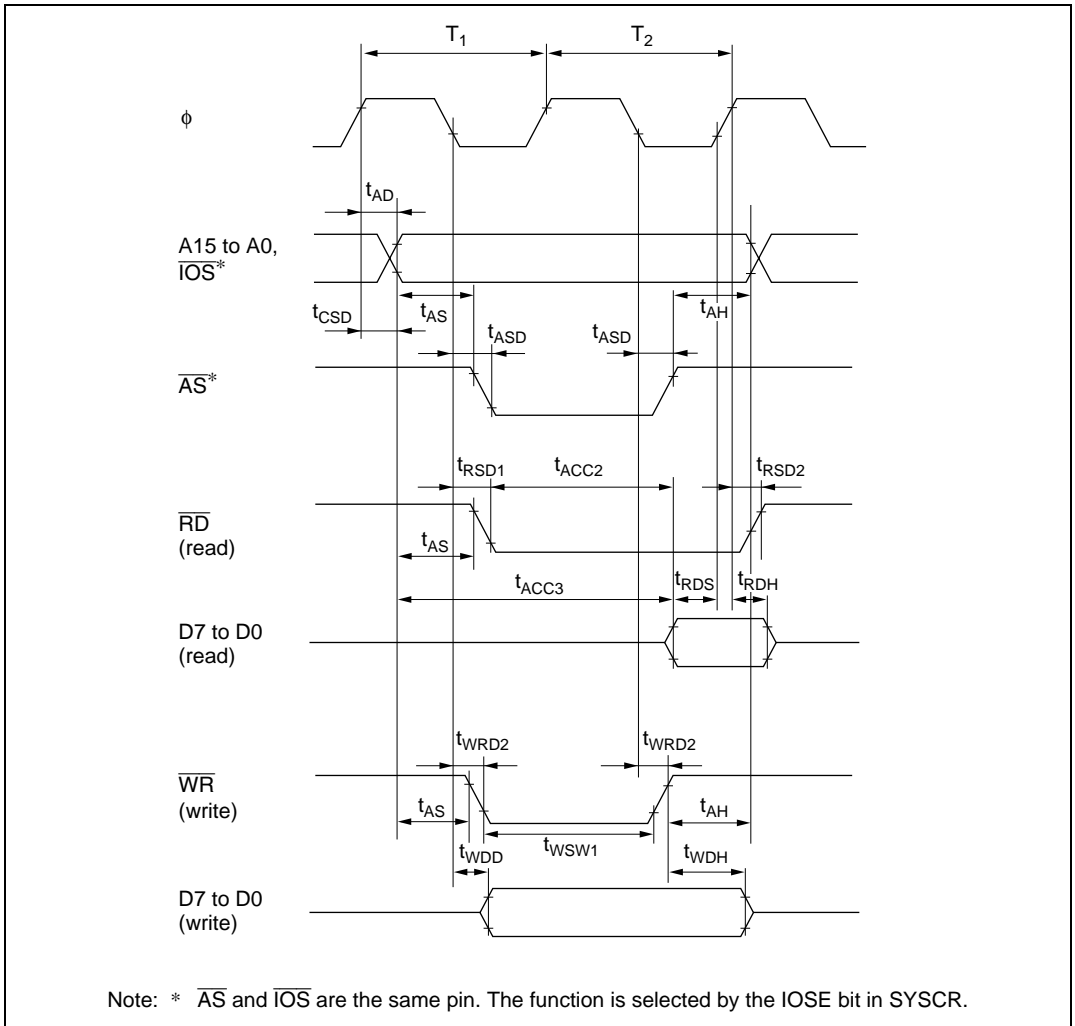


Figure 25.10 Basic Bus Timing (Two-State Access)

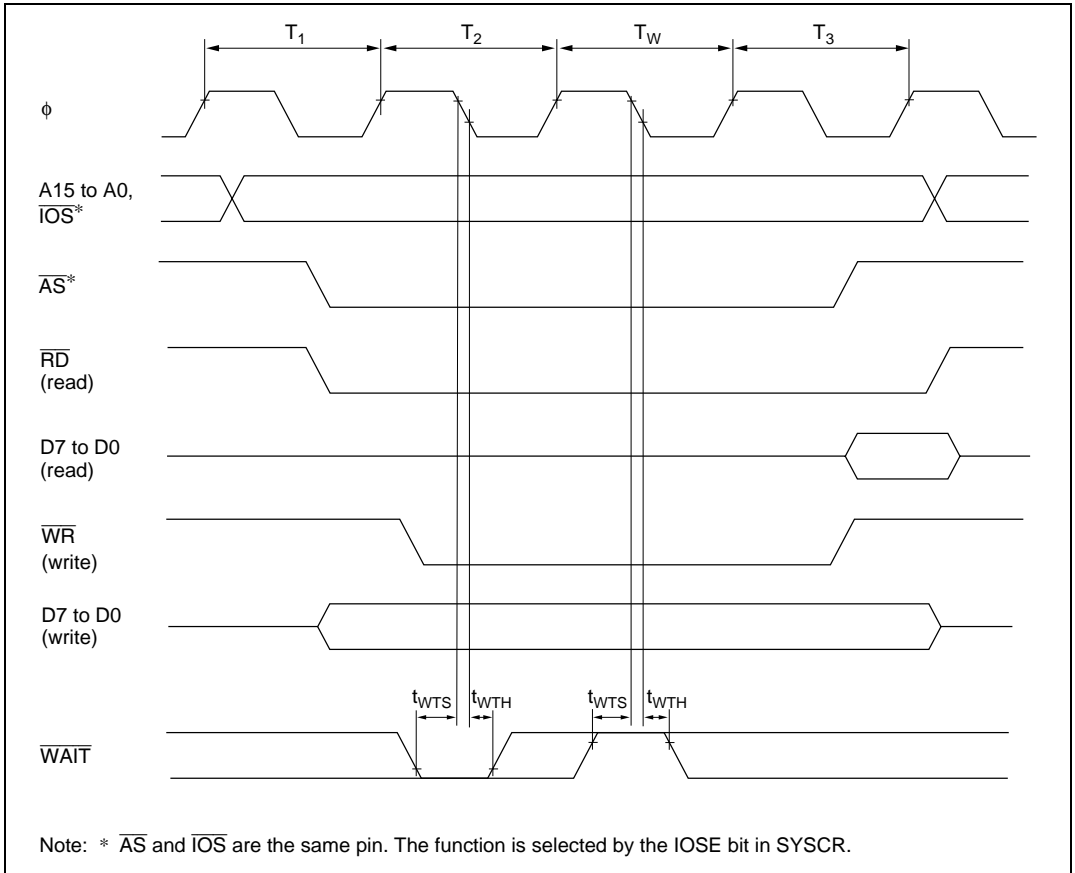


Figure 25.12 Basic Bus Timing (Three-State Access with One Wait State)

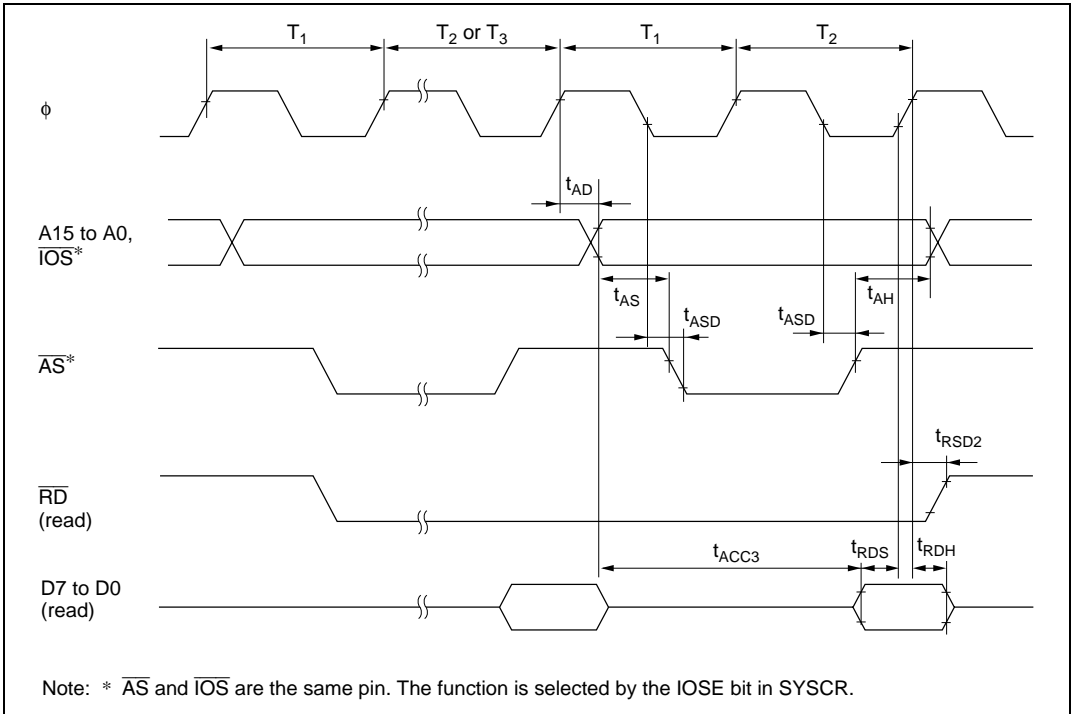


Figure 25.13 Burst ROM Access Timing (Two-State Access)

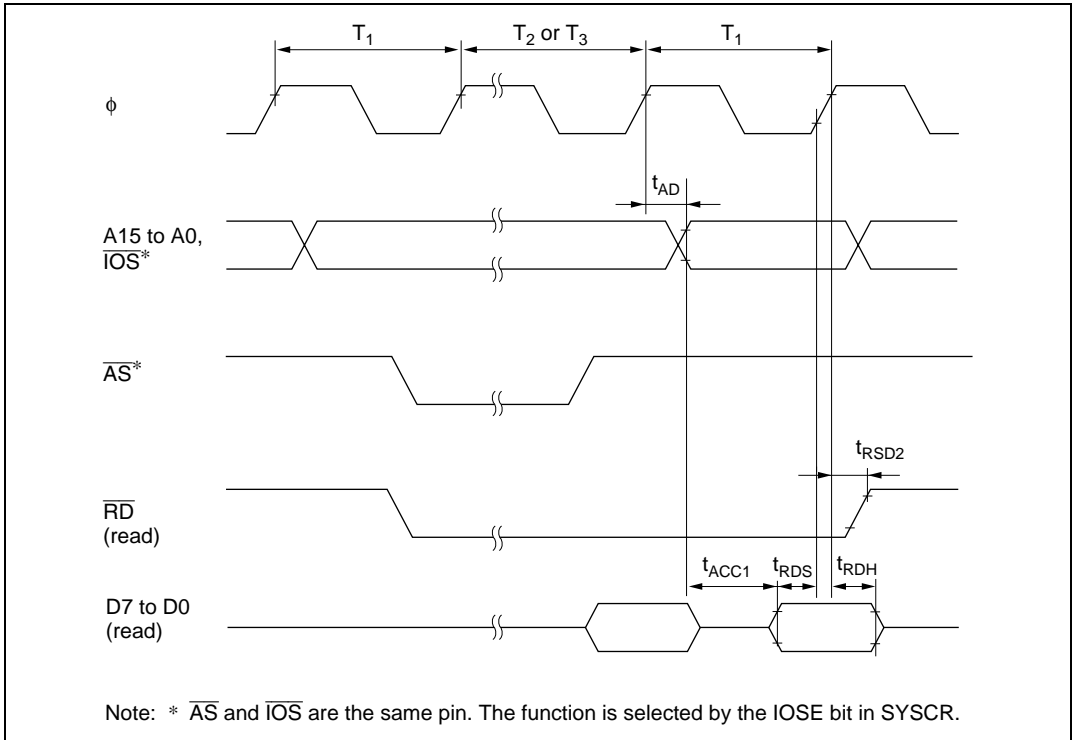


Figure 25.14 Burst ROM Access Timing (One-State Access)

25.6.4 Timing of On-Chip Supporting Modules

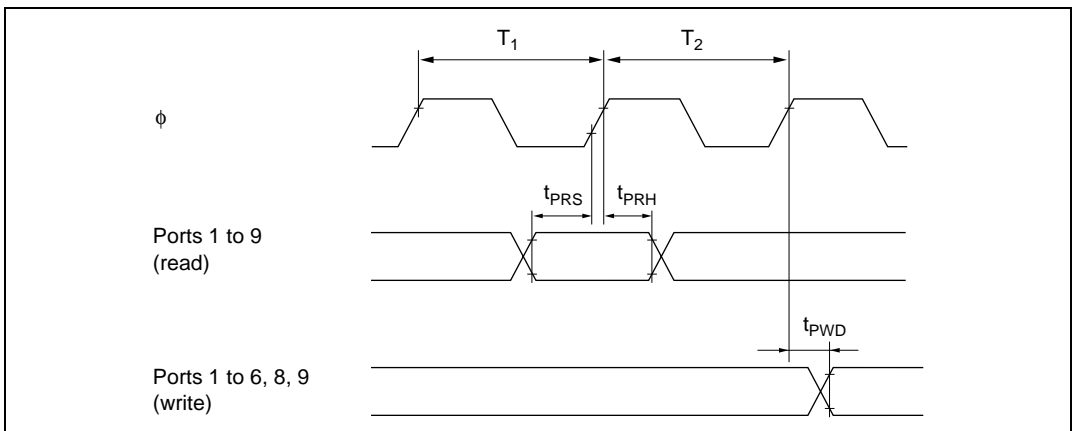


Figure 25.15 I/O Port Input/Output Timing

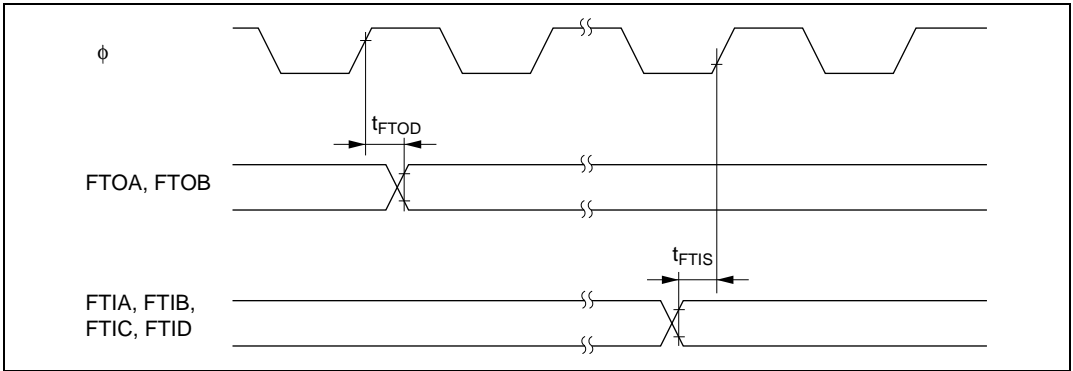


Figure 25.16 FRT Input/Output Timing

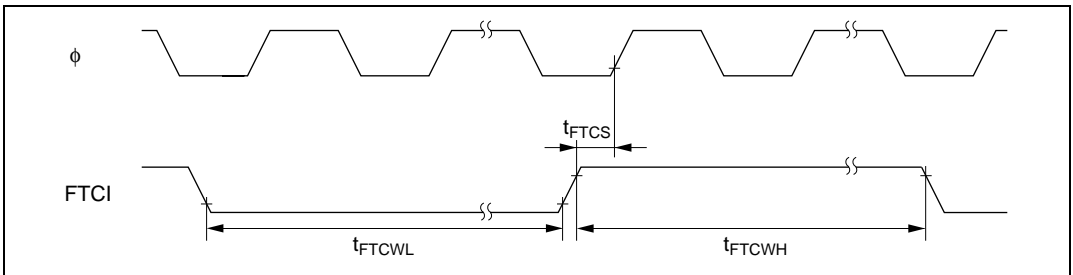


Figure 25.17 FRT Clock Input Timing

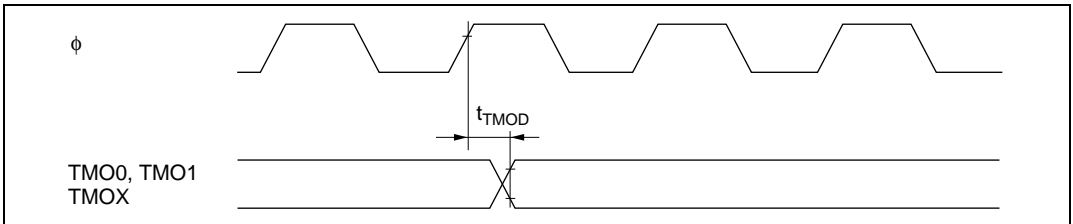


Figure 25.18 8-Bit Timer Output Timing

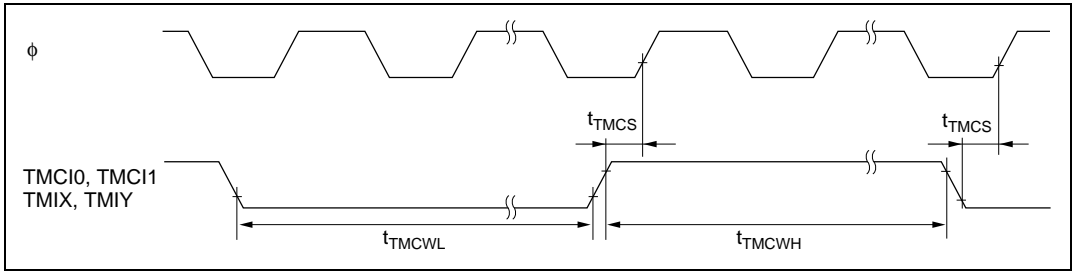


Figure 25.19 8-Bit Timer Clock Input Timing

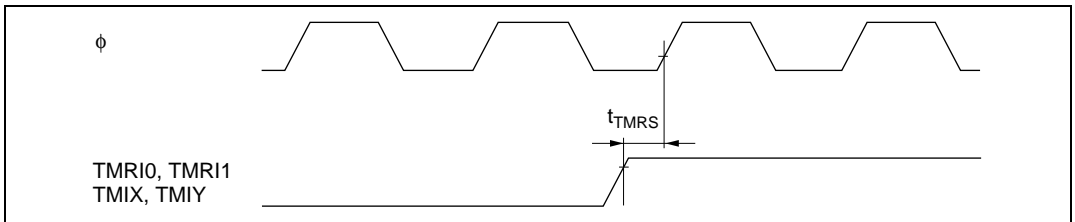


Figure 25.20 8-Bit Timer Reset Input Timing

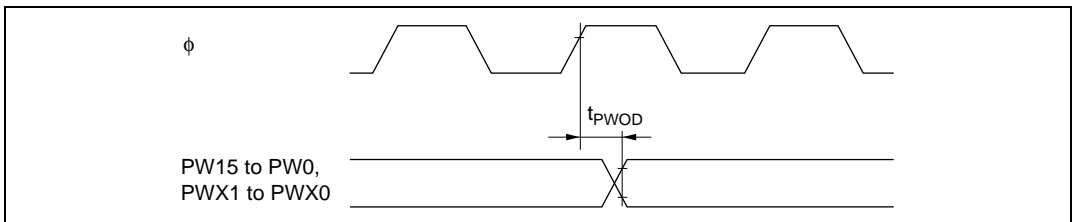


Figure 25.21 PWM, PWMX Output Timing

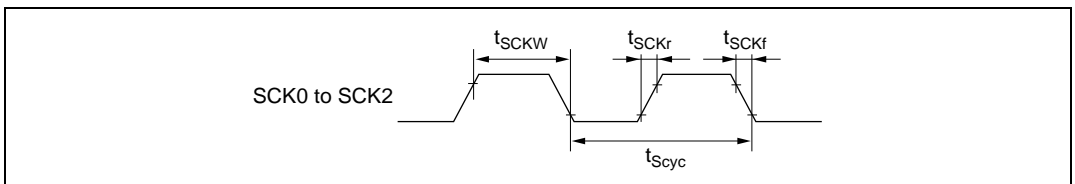


Figure 25.22 SCK Clock Input Timing

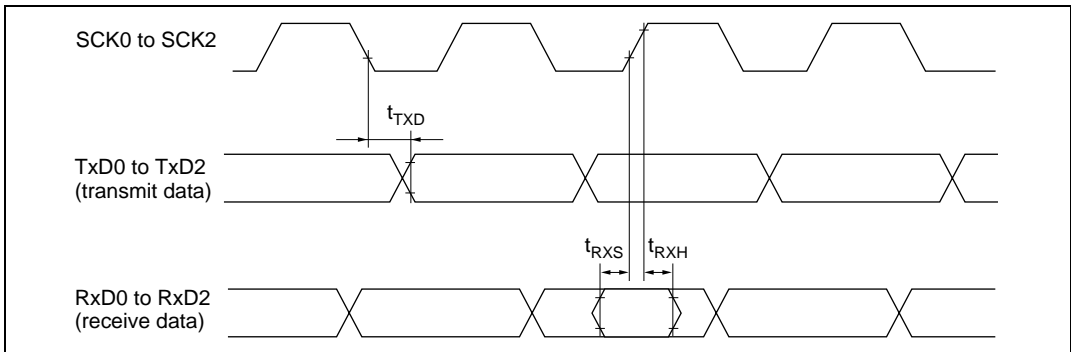


Figure 25.23 SCI Input/Output Timing (Synchronous Mode)

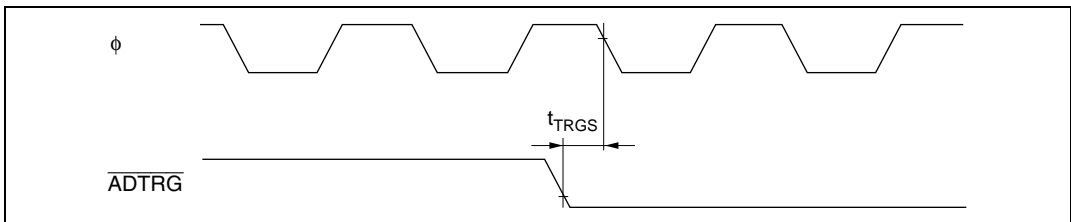
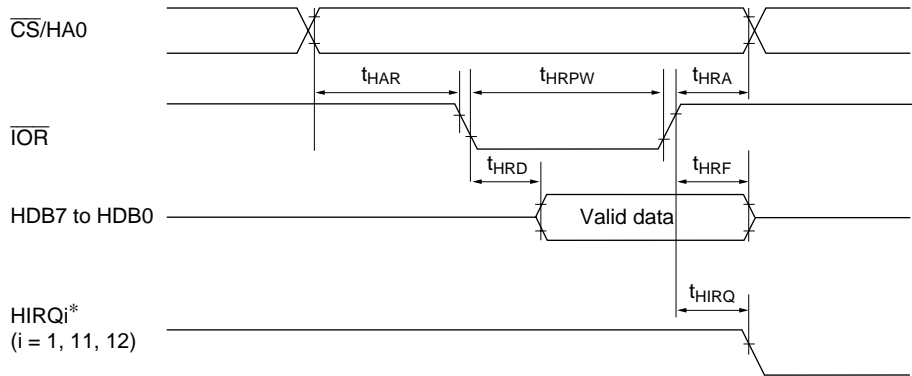


Figure 25.24 A/D Converter External Trigger Input Timing

Host interface read timing

Note: * The rising edge timing is the same as the port 4 output timing. See figure 25.15.

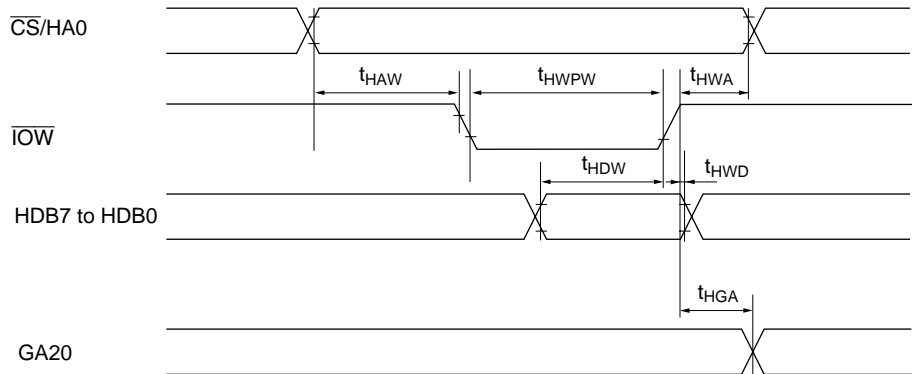
Host interface write timing

Figure 25.25 Host Interface Timing

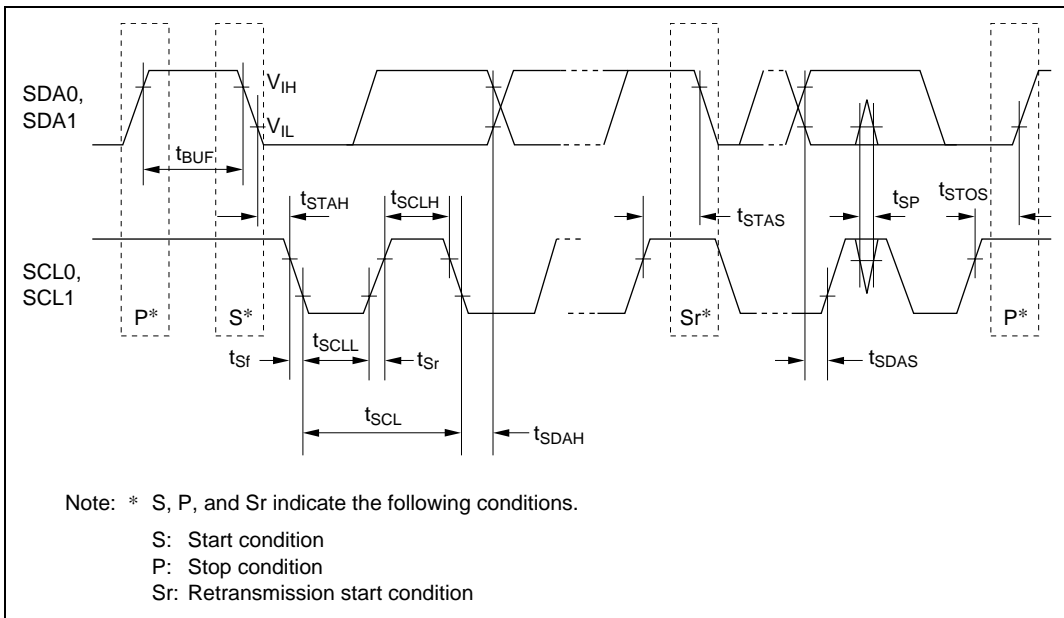


Figure 25.26 I²C Bus Interface Input/Output Timing (Option)

Appendix A Instruction Set

A.1 Instruction

Operation Notation

| | |
|----------------|---|
| Rd | General register (destination) ^{*1} |
| Rs | General register (source) ^{*1} |
| Rn | General register ^{*1} |
| ERn | General register (32-bit register) |
| MAC | Multiply-and-accumulate register (32-bit register) ^{*2} |
| (EAd) | Destination operand |
| (EAs) | Source operand |
| EXR | Extend register |
| CCR | Condition code register |
| N | N (negative) flag in CCR |
| Z | Z (zero) flag in CCR |
| V | V (overflow) flag in CCR |
| C | C (carry) flag in CCR |
| PC | Program counter |
| SP | Stack pointer |
| #IMM | Immediate data |
| disp | Displacement |
| + | Addition |
| − | Subtraction |
| × | Multiplication |
| ÷ | Division |
| ^ | Logical AND |
| ∨ | Logical OR |
| ⊕ | Exclusive logical OR |
| → | Transfer from left-hand operand to right-hand operand, or transition from left-hand state to right-hand state |
| ¬ | NOT (logical complement) |
| () < > | Operand contents |
| :8/:16/:24/:32 | 8-, 16-, 24-, or 32-bit length |

Notes: 1. General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit registers (ER0 to ER7).

2. MAC instructions cannot be used in the H8S/2138 Group and H8S/2134 Group.

Condition Code Notation

| Symbol | Meaning |
|---------------|---------------------------------------|
| ↑ | Changes according operation result. |
| * | Indeterminate (value not guaranteed). |
| 0 | Always cleared to 0. |
| 1 | Always set to 1. |
| — | Not affected by operation result. |

Table A.1 Instruction Set

1. Data Transfer Instructions

| Mnemonic | Size | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | |
|----------|----------------------|--|----|------|----------|-------------|-----|---------|------|-------------------------|----------------|---|---|---|---|---|-----------------------------|----------|
| | | #xx | Rn | @ERn | @(d,ERn) | @-ERn/@ERn+ | @aa | @(d,PC) | @@aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | |
| MOV | MOV.B #xx:8,Rd | B | 2 | | | | | | | #xx:8→Rd8 | — | — | ↑ | ↓ | 0 | — | 1 | |
| | MOV.B Rs,Rd | B | | 2 | | | | | | Rs8→Rd8 | — | — | ↑ | ↓ | 0 | — | 1 | |
| | MOV.B @ERs,Rd | B | | | 2 | | | | | @ERs→Rd8 | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.B @(d:16,ERs),Rd | B | | | | 4 | | | | @(d:16,ERs)→Rd8 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.B @(d:32,ERs),Rd | B | | | | | 8 | | | @(d:32,ERs)→Rd8 | — | — | ↑ | ↓ | 0 | — | 5 | |
| | MOV.B @ERs+,Rd | B | | | | | | 2 | | @ERs→Rd8,ERs32+1→ERs32 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.B @aa:8,Rd | B | | | | | | | 2 | @aa:8→Rd8 | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.B @aa:16,Rd | B | | | | | | | 4 | @aa:16→Rd8 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.B @aa:32,Rd | B | | | | | | | 6 | @aa:32→Rd8 | — | — | ↑ | ↓ | 0 | — | 4 | |
| | MOV.B Rs,@ERd | B | | | 2 | | | | | Rs8→@ERd | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.B Rs,@(d:16,ERd) | B | | | | 4 | | | | Rs8→@(d:16,ERd) | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.B Rs,@(d:32,ERd) | B | | | | | 8 | | | Rs8→@(d:32,ERd) | — | — | ↑ | ↓ | 0 | — | 5 | |
| | MOV.B Rs,@-ERd | B | | | | | | 2 | | ERd32-1→ERd32,Rs8→@ERd | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.B Rs,@aa:8 | B | | | | | | | 2 | Rs8→@aa:8 | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.B Rs,@aa:16 | B | | | | | | | 4 | Rs8→@aa:16 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.B Rs,@aa:32 | B | | | | | | | 6 | Rs8→@aa:32 | — | — | ↑ | ↓ | 0 | — | 4 | |
| | MOV.W #xx:16,Rd | W | 4 | | | | | | | #xx:16→Rd16 | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.W Rs,Rd | W | | 2 | | | | | | Rs16→Rd16 | — | — | ↑ | ↓ | 0 | — | 1 | |
| | MOV.W @ERs,Rd | W | | | 2 | | | | | @ERs→Rd16 | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.W @(d:16,ERs),Rd | W | | | | 4 | | | | @(d:16,ERs)→Rd16 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.W @(d:32,ERs),Rd | W | | | | | 8 | | | @(d:32,ERs)→Rd16 | — | — | ↑ | ↓ | 0 | — | 5 | |
| | MOV.W @ERs+,Rd | W | | | | | | 2 | | @ERs→Rd16,ERs32+2→ERs32 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.W @aa:16,Rd | W | | | | | | | 4 | @aa:16→Rd16 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.W @aa:32,Rd | W | | | | | | | 6 | @aa:32→Rd16 | — | — | ↑ | ↓ | 0 | — | 4 | |
| | MOV.W Rs,@ERd | W | | | 2 | | | | | Rs16→@ERd | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.W Rs,@(d:16,ERd) | W | | | | 4 | | | | Rs16→@(d:16,ERd) | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.W Rs,@(d:32,ERd) | W | | | | | 8 | | | Rs16→@(d:32,ERd) | — | — | ↑ | ↓ | 0 | — | 5 | |
| | MOV.W Rs,@-ERd | W | | | | | | 2 | | ERd32-2→ERd32,Rs16→@ERd | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.W Rs,@aa:16 | W | | | | | | | 4 | Rs16→@aa:16 | — | — | ↑ | ↓ | 0 | — | 3 | |
| | MOV.W Rs,@aa:32 | W | | | | | | | 6 | Rs16→@aa:32 | — | — | ↑ | ↓ | 0 | — | 4 | |

| Mnemonic | | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States*1 | | | | |
|----------|-----------------|--|-----|----|------|-----------|-------------|-----|----------|-----------|----------------|--|---|---|---|-----------------|---|-----|--------|----------|
| | | Size | #xx | Rn | @ERn | @ (q,ERn) | @-ERn/@ERn+ | @aa | @ (q,PC) | | @ @aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| MAC | MAC @ERn+,@ERm+ | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | | | | | | | | | | | [2] | | |
| CLRMAC | CLRMAC | | | | | | | | | | | | | | | | | | | |
| LDMAC | LDMAC ERs,MACH | | | | | | | | | | | | | | | | | | | |
| | LDMAC ERs,MACL | | | | | | | | | | | | | | | | | | | |
| STMAC | STMAC MACH,ERd | | | | | | | | | | | | | | | | | | | |
| | STMAC MACL,ERd | | | | | | | | | | | | | | | | | | | |

3. Logic Instructions

| Mnemonic | | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States ^{*1} | | | | |
|----------|------------------|--|-----|----|------|-----------|-------------|-----|----------|-----------|----------------|---|---|---|---|-----------------------------|---|---|--------|----------|
| | | Size | #xx | Rn | @ERn | @ (d,ERn) | @-ERn/@ERn+ | @aa | @ (d,PC) | | @ @aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| AND | AND.B #xx:8,Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | AND.B Rs,Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | AND.W #xx:16,Rd | W | 4 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 2 | | |
| | AND.W Rs,Rd | W | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | AND.L #xx:32,ERd | L | 6 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 3 | | |
| | AND.L ERs,ERd | L | 4 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 2 | | |
| OR | OR.B #xx:8,Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | OR.B Rs,Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | OR.W #xx:16,Rd | W | 4 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 2 | | |
| | OR.W Rs,Rd | W | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | OR.L #xx:32,ERd | L | 6 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 3 | | |
| | OR.L ERs,ERd | L | 4 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 2 | | |
| XOR | XOR.B #xx:8,Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | XOR.B Rs,Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | XOR.W #xx:16,Rd | W | 4 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 2 | | |
| | XOR.W Rs,Rd | W | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | XOR.L #xx:32,ERd | L | 6 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 3 | | |
| | XOR.L ERs,ERd | L | 4 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 2 | | |
| NOT | NOT.B Rd | B | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | NOT.W Rd | W | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |
| | NOT.L ERd | L | 2 | | | | | | | | | — | — | ↕ | ↕ | 0 | — | 1 | | |

4. Shift Instructions

| Mnemonic | | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States*1 | | | |
|----------|----------------|--|-----|----|------|----------|------------|-----|---------|-----------|----------------|--|---|---|---|-----------------|---|---|--------|
| | | Size | #xx | Rn | @ERn | @(d,ERn) | @-ERn@ERn+ | @aa | @(d,PC) | | @aa | | I | H | N | Z | V | C | Normal |
| SHAL | SHAL.B Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | ↓ | ↓ | 1 | |
| | SHAL.B #2,Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | ↓ | ↓ | 1 | |
| | SHAL.W Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | ↓ | ↓ | 1 | |
| | SHAL.W #2,Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | ↓ | ↓ | 1 | |
| | SHAL.L ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | ↓ | ↓ | 1 | |
| | SHAL.L #2,ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | ↓ | ↓ | 1 | |
| SHAR | SHAR.B Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHAR.B #2,Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHAR.W Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHAR.W #2,Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHAR.L ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHAR.L #2,ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| SHLL | SHLL.B Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLL.B #2,Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLL.W Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLL.W #2,Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLL.L ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLL.L #2,ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| SHLR | SHLR.B Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLR.B #2,Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLR.W Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLR.W #2,Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLR.L ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | SHLR.L #2,ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| ROTXL | ROTXL.B Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | ROTXL.B #2,Rd | B | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | ROTXL.W Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | ROTXL.W #2,Rd | W | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | ROTXL.L ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |
| | ROTXL.L #2,ERd | L | 2 | | | | | | | | | | | ↓ | ↓ | 0 | ↓ | 1 | |

5. Bit Manipulation Instructions

| Mnemonic | | Addressing Mode and Instruction Length (Bytes) | | | | | | | | | Operation | | | | | Condition Code | | | | | No. of States ^{*1} | | | |
|----------------|-------------------|--|-----|----|------|-----------|------------|-----|----------|-------|-----------|--|--|--|--|----------------|---|---|---|---|-----------------------------|---|--------|----------|
| | | Size | #xx | Rn | @ERn | @ (d,ERn) | @-ERn@ERn+ | @aa | @ (d,PC) | @ @aa | | | | | | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | | | | | |
| BSET | BSET #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | | | | | |
| | BSET #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 4 | | | | | |
| | BSET #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 4 | | | | | |
| | BSET #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 5 | | | | | |
| | BSET #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 6 | | | | | |
| | BSET Rn,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | | | | | |
| | BSET Rn,@ERd | B | | 4 | | | | | | | | | | | | | | | 4 | | | | | |
| | BSET Rn,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 4 | | | | | |
| | BSET Rn,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 5 | | | | | |
| BSET Rn,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 6 | | | | | | |
| BCLR | BCLR #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | | | | | |
| | BCLR #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 4 | | | | | |
| | BCLR #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 4 | | | | | |
| | BCLR #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 5 | | | | | |
| | BCLR #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 6 | | | | | |
| | BCLR Rn,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | | | | | |
| | BCLR Rn,@ERd | B | | 4 | | | | | | | | | | | | | | | 4 | | | | | |
| | BCLR Rn,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 4 | | | | | |
| | BCLR Rn,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 5 | | | | | |
| BCLR Rn,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 6 | | | | | | |
| BNOT | BNOT #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | | | | | |
| | BNOT #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 4 | | | | | |
| | BNOT #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 4 | | | | | |
| | BNOT #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 5 | | | | | |
| | BNOT #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 6 | | | | | |
| | BNOT Rn,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | | | | | |
| | BNOT Rn,@ERd | B | | 4 | | | | | | | | | | | | | | | 4 | | | | | |
| | BNOT Rn,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 4 | | | | | |
| | BNOT Rn,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 5 | | | | | |
| BNOT Rn,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 6 | | | | | | |

| Mnemonic | | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Condition Code | | | | | No. of States ^{*1} | | | | | |
|----------------|-------------------|--|-----|----|------|------------|-------------|-----|-----------|--------------------------|----------------------------|-----------|---|---|-----------------------------|---|---|---|--------|----------|
| | | Size | #xx | Rn | @ERn | @({1,ERn}) | @-ERn/@ERn+ | @aa | @({1,PC}) | @@aa | | Operation | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| BTST | BTST #xx:3,Rd | B | 2 | | | | | | | | \neg (#xx:3 of Rd8)→Z | — | — | — | ↑ | — | — | — | 1 | |
| | BTST #xx:3,@ERd | B | | 4 | | | | | | | \neg (#xx:3 of @ERd)→Z | — | — | — | ↑ | — | — | — | 3 | |
| | BTST #xx:3,@aa:8 | B | | | | | 4 | | | | \neg (#xx:3 of @aa:8)→Z | — | — | — | ↑ | — | — | — | 3 | |
| | BTST #xx:3,@aa:16 | B | | | | | 6 | | | | \neg (#xx:3 of @aa:16)→Z | — | — | — | ↑ | — | — | — | 4 | |
| | BTST #xx:3,@aa:32 | B | | | | | 8 | | | | \neg (#xx:3 of @aa:32)→Z | — | — | — | ↑ | — | — | — | 5 | |
| | BTST Rn,Rd | B | 2 | | | | | | | | \neg (Rn8 of Rd8)→Z | — | — | — | ↑ | — | — | — | 1 | |
| | BTST Rn,@ERd | B | | 4 | | | | | | | \neg (Rn8 of @ERd)→Z | — | — | — | ↑ | — | — | — | 3 | |
| | BTST Rn,@aa:8 | B | | | | | 4 | | | | \neg (Rn8 of @aa:8)→Z | — | — | — | ↑ | — | — | — | 3 | |
| | BTST Rn,@aa:16 | B | | | | | 6 | | | | \neg (Rn8 of @aa:16)→Z | — | — | — | ↑ | — | — | — | 4 | |
| BTST Rn,@aa:32 | B | | | | | 8 | | | | \neg (Rn8 of @aa:32)→Z | — | — | — | ↑ | — | — | — | 5 | | |
| BLD | BLD #xx:3,Rd | B | 2 | | | | | | | | (#xx:3 of Rd8)→C | — | — | — | — | — | — | ↑ | 1 | |
| | BLD #xx:3,@ERd | B | | 4 | | | | | | | (#xx:3 of @ERd)→C | — | — | — | — | — | — | ↑ | 3 | |
| | BLD #xx:3,@aa:8 | B | | | | | 4 | | | | (#xx:3 of @aa:8)→C | — | — | — | — | — | — | ↑ | 3 | |
| | BLD #xx:3,@aa:16 | B | | | | | 6 | | | | (#xx:3 of @aa:16)→C | — | — | — | — | — | — | ↑ | 4 | |
| | BLD #xx:3,@aa:32 | B | | | | | 8 | | | | (#xx:3 of @aa:32)→C | — | — | — | — | — | — | ↑ | 5 | |
| BILD | BILD #xx:3,Rd | B | 2 | | | | | | | | \neg (#xx:3 of Rd8)→C | — | — | — | — | — | — | ↑ | 1 | |
| | BILD #xx:3,@ERd | B | | 4 | | | | | | | \neg (#xx:3 of @ERd)→C | — | — | — | — | — | — | ↑ | 3 | |
| | BILD #xx:3,@aa:8 | B | | | | | 4 | | | | \neg (#xx:3 of @aa:8)→C | — | — | — | — | — | — | ↑ | 3 | |
| | BILD #xx:3,@aa:16 | B | | | | | 6 | | | | \neg (#xx:3 of @aa:16)→C | — | — | — | — | — | — | ↑ | 4 | |
| | BILD #xx:3,@aa:32 | B | | | | | 8 | | | | \neg (#xx:3 of @aa:32)→C | — | — | — | — | — | — | ↑ | 5 | |
| BST | BST #xx:3,Rd | B | 2 | | | | | | | | C→(#xx:3 of Rd8) | — | — | — | — | — | — | — | 1 | |
| | BST #xx:3,@ERd | B | | 4 | | | | | | | C→(#xx:3 of @ERd) | — | — | — | — | — | — | — | 4 | |
| | BST #xx:3,@aa:8 | B | | | | | 4 | | | | C→(#xx:3 of @aa:8) | — | — | — | — | — | — | — | 4 | |
| | BST #xx:3,@aa:16 | B | | | | | 6 | | | | C→(#xx:3 of @aa:16) | — | — | — | — | — | — | — | 5 | |
| | BST #xx:3,@aa:32 | B | | | | | 8 | | | | C→(#xx:3 of @aa:32) | — | — | — | — | — | — | — | 6 | |
| BIST | BIST #xx:3,Rd | B | 2 | | | | | | | | \neg C→(#xx:3 of Rd8) | — | — | — | — | — | — | — | 1 | |
| | BIST #xx:3,@ERd | B | | 4 | | | | | | | \neg C→(#xx:3 of @ERd) | — | — | — | — | — | — | — | 4 | |
| | BIST #xx:3,@aa:8 | B | | | | | 4 | | | | \neg C→(#xx:3 of @aa:8) | — | — | — | — | — | — | — | 4 | |
| | BIST #xx:3,@aa:16 | B | | | | | 6 | | | | \neg C→(#xx:3 of @aa:16) | — | — | — | — | — | — | — | 5 | |
| | BIST #xx:3,@aa:32 | B | | | | | 8 | | | | \neg C→(#xx:3 of @aa:32) | — | — | — | — | — | — | — | 6 | |

| Mnemonic | | Size | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States*1 | | | |
|----------|--------------------|------|--|----|------|----------|-------------|-----|---------|------|-----------|----------------|---|---|---|---|-----------------|---|--------|----------|
| | | | #xx | Rn | @ERn | @ (L)ERn | @-ERn/@ERn+ | @aa | @ (L)PC | @@aa | | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| BAND | BAND #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | |
| | BAND #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 3 | |
| | BAND #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 3 | |
| | BAND #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 4 | |
| | BAND #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 5 | |
| BIAND | BIAND #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | |
| | BIAND #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 3 | |
| | BIAND #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 3 | |
| | BIAND #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 4 | |
| | BIAND #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 5 | |
| BOR | BOR #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | |
| | BOR #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 3 | |
| | BOR #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 3 | |
| | BOR #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 4 | |
| | BOR #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 5 | |
| BIOR | BIOR #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | |
| | BIOR #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 3 | |
| | BIOR #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 3 | |
| | BIOR #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 4 | |
| | BIOR #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 5 | |
| BXOR | BXOR #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | |
| | BXOR #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 3 | |
| | BXOR #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 3 | |
| | BXOR #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 4 | |
| | BXOR #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 5 | |
| BIXOR | BIXOR #xx:3,Rd | B | 2 | | | | | | | | | | | | | | | | 1 | |
| | BIXOR #xx:3,@ERd | B | | 4 | | | | | | | | | | | | | | | 3 | |
| | BIXOR #xx:3,@aa:8 | B | | | | | 4 | | | | | | | | | | | | 3 | |
| | BIXOR #xx:3,@aa:16 | B | | | | | 6 | | | | | | | | | | | | 4 | |
| | BIXOR #xx:3,@aa:32 | B | | | | | 8 | | | | | | | | | | | | 5 | |

6. Branch Instructions

| Mnemonic | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Branch Condition | Condition Code | | | | | | No. of States ^{*1} | | |
|----------|--|-----|----|------|-----------|-------------|-----|----------|--|------------------|----------------|---|---|---|---|---|-----------------------------|--------|----------|
| | Size | #xx | Rn | @ERn | @ (d,ERn) | @-ERn/@ERn+ | @aa | @ (d,PC) | | | @ @aa | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | |
| Bcc | BRA d:8(BT d:8) | — | | | | | | 2 | if condition is true then PC←PC+d else next; | Always | — | — | — | — | — | — | 2 | | |
| | BRA d:16(BT d:16) | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BRN d:8(BF d:8) | — | | | | | | 2 | | Never | — | — | — | — | — | — | — | 2 | |
| | BRN d:16(BF d:16) | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BHI d:8 | — | | | | | | 2 | | CvZ=0 | — | — | — | — | — | — | — | 2 | |
| | BHI d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BLS d:8 | — | | | | | | 2 | | CvZ=1 | — | — | — | — | — | — | — | 2 | |
| | BLS d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BCC d:8(BHS d:8) | — | | | | | | 2 | | C=0 | — | — | — | — | — | — | — | 2 | |
| | BCC d:16(BHS d:16) | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BCS d:8(BLO d:8) | — | | | | | | 2 | | C=1 | — | — | — | — | — | — | — | 2 | |
| | BCS d:16(BLO d:16) | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BNE d:8 | — | | | | | | 2 | | Z=0 | — | — | — | — | — | — | — | 2 | |
| | BNE d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BEQ d:8 | — | | | | | | 2 | | Z=1 | — | — | — | — | — | — | — | 2 | |
| | BEQ d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BVC d:8 | — | | | | | | 2 | | V=0 | — | — | — | — | — | — | — | 2 | |
| | BVC d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BVS d:8 | — | | | | | | 2 | | V=1 | — | — | — | — | — | — | — | 2 | |
| | BVS d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BPL d:8 | — | | | | | | 2 | | N=0 | — | — | — | — | — | — | — | 2 | |
| | BPL d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BMI d:8 | — | | | | | | 2 | | N=1 | — | — | — | — | — | — | — | 2 | |
| | BMI d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BGE d:8 | — | | | | | | 2 | | N⊕V=0 | — | — | — | — | — | — | — | 2 | |
| | BGE d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BLT d:8 | — | | | | | | 2 | | N⊕V=1 | — | — | — | — | — | — | — | 2 | |
| | BLT d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BGT d:8 | — | | | | | | 2 | | Zv(N⊕V)=0 | — | — | — | — | — | — | — | 2 | |
| | BGT d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |
| | BLE d:8 | — | | | | | | 2 | | Zv(N⊕V)=1 | — | — | — | — | — | — | — | 2 | |
| | BLE d:16 | — | | | | | | 4 | | | — | — | — | — | — | — | — | 3 | |

| Mnemonic | | Size | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States*1 | | | |
|----------|------------|------|--|----|------|----------|-------------|-----|---------|------|-----------|----------------|---|---|---|---|-----------------|---|--------|----------|
| | | | #xx | Rn | @ERn | @(q,ERn) | @-ERn/@ERn+ | @aa | @(q,PC) | @@aa | | — | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| JMP | JMP @ERn | — | | | 2 | | | | | | | | | | | | | | 2 | |
| | JMP @aa:24 | — | | | | | | 4 | | | | | | | | | | | 3 | |
| | JMP @@aa:8 | — | | | | | | | | 2 | | | | | | | | | 4 5 | |
| BSR | BSR d:8 | — | | | | | | | 2 | | | | | | | | | | 3 4 | |
| | BSR d:16 | — | | | | | | 4 | | | | | | | | | | | 4 5 | |
| JSR | JSR @ERn | — | | | 2 | | | | | | | | | | | | | | 3 4 | |
| | JSR @aa:24 | — | | | | | | 4 | | | | | | | | | | | 4 5 | |
| | JSR @@aa:8 | — | | | | | | | | 2 | | | | | | | | | 4 6 | |
| RTS | RTS | — | | | | | | | | 2 | | | | | | | | | 4 5 | |

7. System Control Instructions

| Mnemonic | Addressing Mode and Instruction Length (Bytes) | Size | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States ^{*1} | | |
|----------------|--|------|--|----|----------|-------------|-----|---------|------|--|-----------|----------------|---|---|---|---|-----------------------------|--------|----------|
| | | | #xx | Rn | @(d,ERn) | @-ERn/@ERn+ | @aa | @(d,PC) | @@aa | | | I | H | N | Z | V | C | Normal | Advanced |
| TRAPA | TRAPA #xx:2 | — | | | | | | | | | | | | | | | | 7 [9] | 8 [9] |
| RTE | RTE | — | | | | | | | | | | | | | | | | 5 [9] | |
| SLEEP | SLEEP | — | | | | | | | | | | | | | | | | | 2 |
| LDC | LDC #xx:8,CCR | B | 2 | | | | | | | | | | | | | | | | 1 |
| | LDC #xx:8,EXR | B | 4 | | | | | | | | | | | | | | | | 2 |
| | LDC Rs,CCR | B | 2 | | | | | | | | | | | | | | | | 1 |
| | LDC Rs,EXR | B | 2 | | | | | | | | | | | | | | | | 1 |
| | LDC @ERs,CCR | W | | 4 | | | | | | | | | | | | | | | 3 |
| | LDC @ERs,EXR | W | | 4 | | | | | | | | | | | | | | | 3 |
| | LDC @(d:16,ERs),CCR | W | | | 6 | | | | | | | | | | | | | | 4 |
| | LDC @(d:16,ERs),EXR | W | | | 6 | | | | | | | | | | | | | | 4 |
| | LDC @(d:32,ERs),CCR | W | | | 10 | | | | | | | | | | | | | | 6 |
| | LDC @(d:32,ERs),EXR | W | | | 10 | | | | | | | | | | | | | | 6 |
| | LDC @ERs+,CCR | W | | | | 4 | | | | | | | | | | | | | 4 |
| | LDC @ERs+,EXR | W | | | | 4 | | | | | | | | | | | | | 4 |
| | LDC @aa:16,CCR | W | | | | | 6 | | | | | | | | | | | | 4 |
| LDC @aa:16,EXR | W | | | | | 6 | | | | | | | | | | | | 4 | |
| LDC @aa:32,CCR | W | | | | | | 8 | | | | | | | | | | | 5 | |
| LDC @aa:32,EXR | W | | | | | | 8 | | | | | | | | | | | 5 | |

| Mnemonic | Size | Addressing Mode and Instruction Length (Bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States*1 | | |
|----------------|---------------------|--|----|------|----------|-------------|-----|---------|------------|------------------------|----------------|---|---|---|---|-----------------|--------|----------|
| | | #xx | Rn | @ERn | @(d,ERn) | @-ERn/@ERn+ | @aa | @(d,PC) | @@aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | |
| STC | STC CCR,Rd | B | 2 | | | | | | | CCR→Rd8 | — | — | — | — | — | — | 1 | |
| | STC EXR,Rd | B | 2 | | | | | | | EXR→Rd8 | — | — | — | — | — | — | 1 | |
| | STC CCR,@ERd | W | | 4 | | | | | | CCR→@ERd | — | — | — | — | — | — | 3 | |
| | STC EXR,@ERd | W | | 4 | | | | | | EXR→@ERd | — | — | — | — | — | — | 3 | |
| | STC CCR,@(d:16,ERd) | W | | | 6 | | | | | CCR→@(d:16,ERd) | — | — | — | — | — | — | 4 | |
| | STC EXR,@(d:16,ERd) | W | | | 6 | | | | | EXR→@(d:16,ERd) | — | — | — | — | — | — | 4 | |
| | STC CCR,@(d:32,ERd) | W | | | 10 | | | | | CCR→@(d:32,ERd) | — | — | — | — | — | — | 6 | |
| | STC EXR,@(d:32,ERd) | W | | | 10 | | | | | EXR→@(d:32,ERd) | — | — | — | — | — | — | 6 | |
| | STC CCR,@-ERd | W | | | | 4 | | | | ERd32-2→ERd32,CCR→@ERd | — | — | — | — | — | — | 4 | |
| | STC EXR,@-ERd | W | | | | 4 | | | | ERd32-2→ERd32,EXR→@ERd | — | — | — | — | — | — | 4 | |
| | STC CCR,@aa:16 | W | | | | | 6 | | | CCR→@aa:16 | — | — | — | — | — | — | 4 | |
| | STC EXR,@aa:16 | W | | | | | 6 | | | EXR→@aa:16 | — | — | — | — | — | — | 4 | |
| | STC CCR,@aa:32 | W | | | | | 8 | | | CCR→@aa:32 | — | — | — | — | — | — | 5 | |
| STC EXR,@aa:32 | W | | | | | 8 | | | EXR→@aa:32 | — | — | — | — | — | — | 5 | | |
| ANDC | ANDC #xx:8,CCR | B | 2 | | | | | | | CCR^#xx:8→CCR | ↑ | ↓ | ↓ | ↑ | ↓ | ↓ | 1 | |
| | ANDC #xx:8,EXR | B | 4 | | | | | | | EXR^#xx:8→EXR | — | — | — | — | — | — | 2 | |
| ORC | ORC #xx:8,CCR | B | 2 | | | | | | | CCRv#xx:8→CCR | ↑ | ↓ | ↓ | ↑ | ↓ | ↓ | 1 | |
| | ORC #xx:8,EXR | B | 4 | | | | | | | EXRv#xx:8→EXR | — | — | — | — | — | — | 2 | |
| XORC | XORC #xx:8,CCR | B | 2 | | | | | | | CCR@#xx:8→CCR | ↑ | ↓ | ↓ | ↑ | ↓ | ↓ | 1 | |
| | XORC #xx:8,EXR | B | 4 | | | | | | | EXR@#xx:8→EXR | — | — | — | — | — | — | 2 | |
| NOP | NOP | — | | | | | | | 2 | PC←PC+2 | — | — | — | — | — | — | 1 | |

8. Block Transfer Instructions

| Mnemonic | Addressing Mode and Instruction Length (Bytes) | | | | | | | | | Operation | Condition Code | | | | | No. of States ^{*1} | | | |
|----------|--|-----|----|------|-----------|-------------|-----|----------|-------|-----------|--|---|---|---|---|-----------------------------|---|--------------------|----------|
| | Size | #xx | Rn | @ERn | @ (d,ERn) | @-ERn/@ERn+ | @aa | @ (d,PC) | @ @aa | | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | |
| EEPMOV | EEPMOV.B | — | | | | | | | | 4 | if R4L≠0 Repeat @ER5→@ER6 ER5+1→ER5 ER6+1→ER6 R4L-1→R4L Until R4L=0 else next; | — | — | — | — | — | — | 4+2n ^{*2} | |
| | EEPMOV.W | — | | | | | | | | 4 | if R4≠0 Repeat @ER5→@ER6 ER5+1→ER5 ER6+1→ER6 R4-1→R4 Until R4=0 else next; | — | — | — | — | — | — | 4+2n ^{*2} | |

- Notes: 1. The number of states is the number of states required for execution when the instruction and its operands are located in on-chip memory.
2. n is the initial value set in R4L or R4.
3. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
4. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

- [1] 7 states when the number of saved/restored registers is 2, 9 states when 3, and 11 states when 4.
- [2] Cannot be used with the H8S/2138 Group and H8S/2134 Group.
- [3] Set to 1 when there is a carry from or borrow to bit 11; otherwise cleared to 0.
- [4] Set to 1 when there is a carry from or borrow to bit 27; otherwise cleared to 0.
- [5] If the result is zero, the previous value of the flag is retained; otherwise the flag is cleared to 0.
- [6] Set to 1 if the divisor is negative; otherwise cleared to 0.
- [7] Set to 1 if the divisor is zero; otherwise cleared to 0.
- [8] Set to 1 if the quotient is negative; otherwise cleared to 0.
- [9] When EXR is valid, the number of states is increased by 1.

A.2 Instruction Codes

Table A.2 Instruction Codes

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------|--------------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| ADD | ADD.B #xx:8,Rd | B | 8 | rd | IMM | | | | | | | | | | | | | | | |
| | ADD.B Rs,Rd | B | 0 | 8 | rs | rd | | | | | | | | | | | | | | |
| | ADD.W #xx:16,Rd | W | 7 | 9 | 1 | rd | IMM | | | | | | | | | | | | | |
| | ADD.W Rs,Rd | W | 0 | 9 | rs | rd | | | | | | | | | | | | | | |
| | ADD.L #xx:32,ERd | L | 7 | A | 1 | 0 | erd | IMM | | | | | | | | | | | | |
| | ADD.L ERs,ERd | L | 0 | A | 1 | ers | 0 | erd | | | | | | | | | | | | |
| ADDS | ADDS #1,ERd | L | 0 | B | 0 | 0 | 0 | erd | | | | | | | | | | | | |
| | ADDS #2,ERd | L | 0 | B | 8 | 0 | 0 | erd | | | | | | | | | | | | |
| | ADDS #4,ERd | L | 0 | B | 9 | 0 | 0 | erd | | | | | | | | | | | | |
| | ADDS #xx:8,Rd | B | 9 | rd | IMM | | | | | | | | | | | | | | | |
| | ADDS Rs,Rd | B | 0 | E | rs | rd | | | | | | | | | | | | | | |
| AND | AND.B #xx:8,Rd | B | E | rd | IMM | | | | | | | | | | | | | | | |
| | AND.B Rs,Rd | B | 1 | 6 | rs | rd | | | | | | | | | | | | | | |
| | AND.W #xx:16,Rd | W | 7 | 9 | 6 | rd | IMM | | | | | | | | | | | | | |
| | AND.W Rs,Rd | W | 6 | 6 | rs | rd | | | | | | | | | | | | | | |
| | AND.L #xx:32,ERd | L | 7 | A | 6 | 0 | erd | IMM | | | | | | | | | | | | |
| ANDC | ANDC.L ERs,ERd | L | 0 | 1 | F | 0 | 6 | 6 | 0 | ers | 0 | erd | | | | | | | | |
| | ANDC #xx:8,CCR | B | 0 | 6 | IMM | | | | | | | | | | | | | | | |
| | ANDC #xx:8,EXR | B | 0 | 1 | 4 | 1 | 0 | 6 | IMM | | | | | | | | | | | |
| | BAND #xx:3,Rd | B | 7 | 6 | 0 | IMM | rd | | | | | | | | | | | | | |
| | BAND #xx:3,@ERd | B | 7 | C | 0 | erd | 0 | 7 | 6 | 0 | IMM | 0 | | | | | | | | |
| | BAND #xx:3,@aa:8 | B | 7 | E | abs | abs | 7 | 6 | 0 | IMM | 0 | | | | | | | | | |
| Bcc | BAND #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | 7 | 6 | 0 | IMM | 0 | | | | | | | | |
| | BAND #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | 7 | 6 | 0 | IMM | 0 | | | | | | | | |
| | BRA d:8 (BT d:8) | — | 4 | 0 | disp | | | | | | | | | | | | | | | |
| | BRA d:16 (BT d:16) | — | 5 | 8 | 0 | 0 | disp | | | | | | | | | | | | | |
| | BRN d:8 (BF d:8) | — | 4 | 1 | disp | | | | | | | | | | | | | | | |
| | BRN d:16 (BF d:16) | — | 5 | 8 | 1 | 0 | disp | | | | | | | | | | | | | |

| Instruc- tion | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|------------------|---------------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| Bcc | BHI d:8 | — | 4 | 2 | disp | | | | | | | | | | | | | | | |
| | BHI d:16 | — | 5 | 8 | 2 | 0 | disp | | | | | | | | | | | | | |
| | BLS d:8 | — | 4 | 3 | disp | | | | | | | | | | | | | | | |
| | BLS d:16 | — | 5 | 8 | 3 | 0 | disp | | | | | | | | | | | | | |
| | BCC d:8 (BHS d:8) | — | 4 | 4 | disp | | | | | | | | | | | | | | | |
| | BCC d:16 (BHS d:16) | — | 5 | 8 | 4 | 0 | disp | | | | | | | | | | | | | |
| | BCS d:8 (BLO d:8) | — | 4 | 5 | disp | | | | | | | | | | | | | | | |
| | BCS d:16 (BLO d:16) | — | 5 | 8 | 5 | 0 | disp | | | | | | | | | | | | | |
| | BNE d:8 | — | 4 | 6 | disp | | | | | | | | | | | | | | | |
| | BNE d:16 | — | 5 | 8 | 6 | 0 | disp | | | | | | | | | | | | | |
| | BEQ d:8 | — | 4 | 7 | disp | | | | | | | | | | | | | | | |
| | BEQ d:16 | — | 5 | 8 | 7 | 0 | disp | | | | | | | | | | | | | |
| | BVC d:8 | — | 4 | 8 | disp | | | | | | | | | | | | | | | |
| | BVC d:16 | — | 5 | 8 | 8 | 0 | disp | | | | | | | | | | | | | |
| | BVS d:8 | — | 4 | 9 | disp | | | | | | | | | | | | | | | |
| | BVS d:16 | — | 5 | 8 | 9 | 0 | disp | | | | | | | | | | | | | |
| BPL d:8 | — | 4 | A | disp | | | | | | | | | | | | | | | | |
| BPL d:16 | — | 5 | 8 | A | 0 | disp | | | | | | | | | | | | | | |
| BMI d:8 | — | 4 | B | disp | | | | | | | | | | | | | | | | |
| BMI d:16 | — | 5 | 8 | B | 0 | disp | | | | | | | | | | | | | | |
| BGE d:8 | — | 4 | C | disp | | | | | | | | | | | | | | | | |
| BGE d:16 | — | 5 | 8 | C | 0 | disp | | | | | | | | | | | | | | |
| BLT d:8 | — | 4 | D | disp | | | | | | | | | | | | | | | | |
| BLT d:16 | — | 5 | 8 | D | 0 | disp | | | | | | | | | | | | | | |
| BGT d:8 | — | 4 | E | disp | | | | | | | | | | | | | | | | |
| BGT d:16 | — | 5 | 8 | E | 0 | disp | | | | | | | | | | | | | | |
| BLE d:8 | — | 4 | F | disp | | | | | | | | | | | | | | | | |
| BLE d:16 | — | 5 | 8 | F | 0 | disp | | | | | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------------|--------------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|---|-------|-------|---|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| BCLR | BCLR #xx:3,Rd | B | 7 | 2 | 0:IMM | rd | | | | | | | | | | | | | | |
| | BCLR #xx:3,@ERd | B | 7 | D | 0:erd | 0 | 7 | 2 | 0:IMM | 0 | | | | | | | | | | |
| | BCLR #xx:3,@aa:8 | B | 7 | F | abs | | 7 | 2 | 0:IMM | 0 | | | | | | | | | | |
| | BCLR #xx:3,@aa:16 | B | 6 | A | 1 | 8 | abs | | 7 | 2 | 0:IMM | 0 | | | | | | | | |
| | BCLR #xx:3,@aa:32 | B | 6 | A | 3 | 8 | abs | | | | | | 7 | 2 | 0:IMM | 0 | | | | |
| | BCLR Rn,Rd | B | 6 | 2 | rn | rd | | | | | | | | | | | | | | |
| BIAND | BCLR Rn,@ERd | B | 7 | D | 0:erd | 0 | 6 | 2 | m | 0 | | | | | | | | | | |
| | BCLR Rn,@aa:8 | B | 7 | F | abs | | 6 | 2 | m | 0 | | | | | | | | | | |
| | BCLR Rn,@aa:16 | B | 6 | A | 1 | 8 | abs | | 6 | 2 | rn | 0 | | | | | | | | |
| | BCLR Rn,@aa:32 | B | 6 | A | 3 | 8 | abs | | | | | | 6 | 2 | rn | 0 | | | | |
| | BIAND #xx:3,Rd | B | 7 | 6 | 1:IMM | rd | | | | | | | | | | | | | | |
| | BIAND #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 6 | 1:IMM | 0 | | | | | | | | | | |
| BILD | BIAND #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 6 | 1:IMM | 0 | | | | | | | | | | |
| | BIAND #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 6 | 1:IMM | 0 | | | | | | | | |
| | BIAND #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | 7 | 6 | 1:IMM | 0 | | | | |
| | BILD #xx:3,Rd | B | 7 | 7 | 1:IMM | rd | | | | | | | | | | | | | | |
| | BILD #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 7 | 1:IMM | 0 | | | | | | | | | | |
| | BILD #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 7 | 1:IMM | 0 | | | | | | | | | | |
| BIOR | BILD #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 7 | 1:IMM | 0 | | | | | | | | |
| | BILD #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | 7 | 7 | 1:IMM | 0 | | | | |
| | BIOR #xx:3,Rd | B | 7 | 4 | 1:IMM | rd | | | | | | | | | | | | | | |
| | BIOR #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 4 | 1:IMM | 0 | | | | | | | | | | |
| | BIOR #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 4 | 1:IMM | 0 | | | | | | | | | | |
| | BIOR #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 4 | 1:IMM | 0 | | | | | | | | |
| BIOR #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | 7 | 4 | 1:IMM | 0 | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------|--------------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|-------|---|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| BIST | BIST #xx:3,Rd | B | 6 | 7 | 1:IMM | rd | | | | | | | | | | | | | | |
| | BIST #xx:3,@ERd | B | 7 | D | 0:erd | 0 | 6 | 7 | 1:IMM | 0 | | | | | | | | | | |
| | BIST #xx:3,@aa:8 | B | 7 | F | abs | | 6 | 7 | 1:IMM | 0 | | | | | | | | | | |
| | BIST #xx:3,@aa:16 | B | 6 | A | 1 | 8 | abs | | 6 | 7 | 1:IMM | 0 | | | | | | | | |
| | BIST #xx:3,@aa:32 | B | 6 | A | 3 | 8 | abs | | abs | | 6 | 7 | 1:IMM | 0 | | | | | | |
| BIXOR | BIXOR #xx:3,Rd | B | 7 | 5 | 1:IMM | rd | | | | | | | | | | | | | | |
| | BIXOR #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 5 | 1:IMM | 0 | | | | | | | | | | |
| | BIXOR #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 5 | 1:IMM | 0 | | | | | | | | | | |
| | BIXOR #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 5 | 1:IMM | 0 | | | | | | | | |
| | BIXOR #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | abs | | 7 | 5 | 1:IMM | 0 | | | | | | |
| BLD | BLD #xx:3,Rd | B | 7 | 7 | 0:IMM | rd | | | | | | | | | | | | | | |
| | BLD #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 7 | 0:IMM | 0 | | | | | | | | | | |
| | BLD #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 7 | 0:IMM | 0 | | | | | | | | | | |
| | BLD #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 7 | 0:IMM | 0 | | | | | | | | |
| | BLD #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | abs | | 7 | 7 | 0:IMM | 0 | | | | | | |
| BNOT | BNOT #xx:3,Rd | B | 7 | 1 | 0:IMM | rd | | | | | | | | | | | | | | |
| | BNOT #xx:3,@ERd | B | 7 | D | 0:erd | 0 | 7 | 1 | 0:IMM | 0 | | | | | | | | | | |
| | BNOT #xx:3,@aa:8 | B | 7 | F | abs | | 7 | 1 | 0:IMM | 0 | | | | | | | | | | |
| | BNOT #xx:3,@aa:16 | B | 6 | A | 1 | 8 | abs | | 7 | 1 | 0:IMM | 0 | | | | | | | | |
| | BNOT #xx:3,@aa:32 | B | 6 | A | 3 | 8 | abs | | abs | | 7 | 1 | 0:IMM | 0 | | | | | | |
| BNOT Rn,Rd | BNOT Rn,Rd | B | 6 | 1 | rn | rd | | | | | | | | | | | | | | |
| | BNOT Rn,@ERd | B | 7 | D | 0:erd | 0 | 6 | 1 | m | 0 | | | | | | | | | | |
| | BNOT Rn,@aa:8 | B | 7 | F | abs | | 6 | 1 | m | 0 | | | | | | | | | | |
| | BNOT Rn,@aa:16 | B | 6 | A | 1 | 8 | abs | | 6 | 1 | rn | 0 | | | | | | | | |
| | BNOT Rn,@aa:32 | B | 6 | A | 3 | 8 | abs | | abs | | 6 | 1 | rn | 0 | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------|-------------------|------|--------------------|----------|------------|----------|----------|----------|-----------|----------|-----------|-----------|--|--|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| BOR | BOR #xx:3,Rd | B | 7 | 4 | 0:iMMI: rd | | | | | | | | | | | | | | | |
| | BOR #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 4 | 0:iMMI: 0 | | | | | | | | | | | |
| | BOR #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 4 | 0:iMMI: 0 | | | | | | | | | | | |
| | BOR #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 4 | 0:iMMI: 0 | | | | | | | | | |
| | BOR #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | | | | | | | | |
| | BSET #xx:3,Rd | B | 7 | 0 | 0:iMMI: rd | | | | | | | | | | | | | | | |
| BSET | BSET #xx:3,@ERd | B | 7 | D | 0:erd | 0 | 7 | 0 | 0:iMMI: 0 | | | | | | | | | | | |
| | BSET #xx:3,@aa:8 | B | 7 | F | abs | | 7 | 0 | 0:iMMI: 0 | | | | | | | | | | | |
| | BSET #xx:3,@aa:16 | B | 6 | A | 1 | 8 | abs | | 7 | 0 | 0:iMMI: 0 | | | | | | | | | |
| | BSET #xx:3,@aa:32 | B | 6 | A | 3 | 8 | abs | | | | | | | | | | | | | |
| | BSET Rn,Rd | B | 6 | 0 | rn | rd | | | | | | | | | | | | | | |
| | BSET Rn,@ERd | B | 7 | D | 0:erd | 0 | 6 | 0 | m | 0 | | | | | | | | | | |
| | BSET Rn,@aa:8 | B | 7 | F | abs | | 6 | 0 | m | 0 | | | | | | | | | | |
| | BSET Rn,@aa:16 | B | 6 | A | 1 | 8 | abs | | 6 | 0 | rn | 0 | | | | | | | | |
| | BSET Rn,@aa:32 | B | 6 | A | 3 | 8 | abs | | | | | | | | | | | | | |
| | BSR di:8 | — | 5 | 5 | disp | | | | | | | | | | | | | | | |
| BST | BSR di:16 | — | 5 | C | 0 | 0 | disp | | | | | | | | | | | | | |
| | BST #xx:3,Rd | B | 6 | 7 | 0:iMMI: rd | | | | | | | | | | | | | | | |
| BTST | BST #xx:3,@ERd | B | 7 | D | 0:erd | 0 | 6 | 7 | 0:iMMI: 0 | | | | | | | | | | | |
| | BST #xx:3,@aa:8 | B | 7 | F | abs | | 6 | 7 | 0:iMMI: 0 | | | | | | | | | | | |
| | BST #xx:3,@aa:16 | B | 6 | A | 1 | 8 | abs | | 6 | 7 | 0:iMMI: 0 | | | | | | | | | |
| | BST #xx:3,@aa:32 | B | 6 | A | 3 | 8 | abs | | | | | | | | | | | | | |
| | BTST #xx:3,Rd | B | 7 | 3 | 0:iMMI: rd | | | | | | | | | | | | | | | |
| | BTST #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 3 | 0:iMMI: 0 | | | | | | | | | | | |
| BTST | BTST #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 3 | 0:iMMI: 0 | | | | | | | | | | | |
| | BTST #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | 7 | 3 | 0:iMMI: 0 | | | | | | | | | |
| | BTST #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | | | | | | | | |
| | BTST Rn,Rd | B | 6 | 3 | rn | rd | | | | | | | | | | | | | | |
| | BTST Rn,@ERd | B | 7 | C | 0:erd | 0 | 6 | 3 | m | 0 | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------|-------------------|------|--|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| BTST | BTST Rn, @aa:8 | B | 7 | E | 6 | 3 | m | 0 | | | | | | | | | | | | |
| | BTST Rn, @aa:16 | B | 6 | A | 1 | 0 | abs | | | | | | | | | | | | | |
| | BTST Rn, @aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | | | | | | | | |
| BXOR | BXOR #xx:3,Rd | B | 7 | 5 | 0:IMM | rd | | | | | | | | | | | | | | |
| | BXOR #xx:3,@ERd | B | 7 | C | 0:erd | 0 | 7 | 5 | 0:IMM | 0 | | | | | | | | | | |
| | BXOR #xx:3,@aa:8 | B | 7 | E | abs | | 7 | 5 | 0:IMM | 0 | | | | | | | | | | |
| | BXOR #xx:3,@aa:16 | B | 6 | A | 1 | 0 | abs | | | | | | | | | | | | | |
| | BXOR #xx:3,@aa:32 | B | 6 | A | 3 | 0 | abs | | | | | | | | | | | | | |
| CLRMAC | CLRMAC | — | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | | | | | | | | | | | | |
| CMP | CMP.B #xx:8,Rd | B | A | rd | IMM | | | | | | | | | | | | | | | |
| | CMP.B Rs,Rd | B | 1 | C | rs | rd | | | | | | | | | | | | | | |
| | CMP.W #xx:16,Rd | W | 7 | 9 | 2 | rd | IMM | | | | | | | | | | | | | |
| | CMP.W Rs,Rd | W | 1 | D | rs | rd | | | | | | | | | | | | | | |
| | CMP.L #xx:32,ERd | L | 7 | A | 2 | 0:erd | | | | | | | | | | | | | | |
| | CMP.L ERs,ERd | L | 1 | F | 1:ers | 0:erd | | | | | | | | | | | | | | |
| DAA | DAA Rd | B | 0 | F | 0 | rd | | | | | | | | | | | | | | |
| DAS | DAS Rd | B | 1 | F | 0 | rd | | | | | | | | | | | | | | |
| DEC | DEC.B Rd | B | 1 | A | 0 | rd | | | | | | | | | | | | | | |
| | DEC.W #1,Rd | W | 1 | B | 5 | rd | | | | | | | | | | | | | | |
| | DEC.W #2,Rd | W | 1 | B | D | rd | | | | | | | | | | | | | | |
| | DEC.L #1,ERd | L | 1 | B | 7 | 0:erd | | | | | | | | | | | | | | |
| DIVXS | DEC.L #2,ERd | L | 1 | B | F | 0:erd | | | | | | | | | | | | | | |
| | DIVXS.B Rs,Rd | B | 0 | 1 | D | 0 | 5 | 1 | rs | rd | | | | | | | | | | |
| DIVXU | DIVXS.W Rs,ERd | W | 0 | 1 | D | 0 | 5 | 3 | rs | 0:erd | | | | | | | | | | |
| | DIVXU.B Rs,Rd | B | 5 | 1 | rs | rd | | | | | | | | | | | | | | |
| | DIVXU.W Rs,ERd | W | 5 | 3 | rs | 0:erd | | | | | | | | | | | | | | |
| EEPMOV | EEPMOV.B | — | 7 | B | 5 | C | 5 | 9 | 8 | F | | | | | | | | | | |
| | EEPMOV.W | — | 7 | B | D | 4 | 5 | 9 | 8 | F | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | | |
|-------------|---------------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|---|---|------|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | | |
| EXTS | EXTS.W Rd | W | 1 | 7 | D | rd | | | | | | | | | | | | | | | |
| | EXTS.L ERd | L | 1 | 7 | F | 0:erd | | | | | | | | | | | | | | | |
| | EXTU.W Rd | W | 1 | 7 | 5 | rd | | | | | | | | | | | | | | | |
| EXTU | EXTU.L ERd | L | 1 | 7 | 7 | 0:erd | | | | | | | | | | | | | | | |
| | INC.B Rd | B | 0 | A | 0 | rd | | | | | | | | | | | | | | | |
| INC | INC.W #1,Rd | W | 0 | B | 5 | rd | | | | | | | | | | | | | | | |
| | INC.W #2,Rd | W | 0 | B | D | rd | | | | | | | | | | | | | | | |
| | INC.L #1,ERd | L | 0 | B | 7 | 0:erd | | | | | | | | | | | | | | | |
| | INC.L #2,ERd | L | 0 | B | F | 0:erd | | | | | | | | | | | | | | | |
| | JMP @ERn | — | 5 | 9 | 0:ern | 0 | | | | | | | | | | | | | | | |
| JMP | JMP @aa:24 | — | 5 | A | | abs | | | | | | | | | | | | | | | |
| | JMP @ @aa:8 | — | 5 | B | abs | | | | | | | | | | | | | | | | |
| | JSR @ERn | — | 5 | D | 0:ern | 0 | | | | | | | | | | | | | | | |
| | JSR @aa:24 | — | 5 | E | | abs | | | | | | | | | | | | | | | |
| | JSR @ @aa:8 | — | 5 | F | abs | | | | | | | | | | | | | | | | |
| LDC | LDC #xx:8,CCR | B | 0 | 7 | IMM | | | | | | | | | | | | | | | | |
| | LDC #xx:8,EXR | B | 0 | 1 | 4 | 1 | 0 | 7 | IMM | | | | | | | | | | | | |
| | LDC Rs,CCR | B | 0 | 3 | 0 | rs | | | | | | | | | | | | | | | |
| | LDC Rs,EXR | B | 0 | 3 | 1 | rs | | | | | | | | | | | | | | | |
| | LDC @ERs,CCR | W | 0 | 1 | 4 | 0 | 6 | 9 | 0:ers | 0 | | | | | | | | | | | |
| | LDC @ERs,EXR | W | 0 | 1 | 4 | 1 | 6 | 9 | 0:ers | 0 | | | | | | | | | | | |
| | LDC @(d:16,ERs),CCR | W | 0 | 1 | 4 | 0 | 6 | F | 0:ers | 0 | disp | | | | | | | | | | |
| | LDC @(d:16,ERs),EXR | W | 0 | 1 | 4 | 1 | 6 | F | 0:ers | 0 | disp | | | | | | | | | | |
| | LDC @(d:32,ERs),CCR | W | 0 | 1 | 4 | 0 | 7 | 8 | 0:ers | 0 | 6 | B | 2 | 0 | disp | | | | | | |
| | LDC @(d:32,ERs),EXR | W | 0 | 1 | 4 | 1 | 7 | 8 | 0:ers | 0 | 6 | B | 2 | 0 | disp | | | | | | |
| LDC @ERs+ | LDC @ERs+,CCR | W | 0 | 1 | 4 | 0 | 6 | D | 0:ers | 0 | | | | | | | | | | | |
| | LDC @ERs+,EXR | W | 0 | 1 | 4 | 1 | 6 | D | 0:ers | 0 | | | | | | | | | | | |
| | LDC @aa:16,CCR | W | 0 | 1 | 4 | 0 | 6 | B | 0 | 0 | abs | | | | | | | | | | |
| | LDC @aa:16,EXR | W | 0 | 1 | 4 | 1 | 6 | B | 0 | 0 | abs | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | |

| Instruc- tion | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | |
|----------------------|-------------------------|------|--|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | |
| LDC | LDC @aa:32,CCR | W | 0 | 1 | 4 | 0 | 6 | B | 2 | 0 | abs | | | | | |
| | LDC @aa:32,EXR | W | 0 | 1 | 4 | 1 | 6 | B | 2 | 0 | abs | | | | | |
| LDM ⁸³ | LDM.L @SP+, (ERn-ERn+1) | L | 0 | 1 | 1 | 0 | 6 | D | 7 | 0;erm+1 | | | | | | |
| | LDM.L @SP+, (ERn-ERn+2) | L | 0 | 1 | 2 | 0 | 6 | D | 7 | 0;erm+2 | | | | | | |
| | LDM.L @SP+, (ERn-ERn+3) | L | 0 | 1 | 3 | 0 | 6 | D | 7 | 0;erm+3 | | | | | | |
| LDMAC | LDMAC ERs, MACH | L | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | | | | | | | | |
| MAC | LDMAC ERs, MACL | L | | | | | | | | | | | | | | |
| | MAC @ERn+, @ERm+ | — | | | | | | | | | | | | | | |
| MOV | MOV.B #xx:8,Rd | B | F | rd | IMM | | | | | | | | | | | |
| | MOV.B Rs,Rd | B | 0 | C | rs | rd | | | | | | | | | | |
| | MOV.B @ERs,Rd | B | 6 | 8 | 0;ers | rd | | | | | | | | | | |
| | MOV.B @(d:16,ERs),Rd | B | 6 | E | 0;ers | rd | disp | | | | | | | | | |
| | MOV.B @(d:32,ERs),Rd | B | 7 | 8 | 0;ers | 0 | 6 | A | 2 | rd | disp | | | | | |
| | MOV.B @ERs+,Rd | B | 6 | C | 0;ers | rd | | | | | | | | | | |
| | MOV.B @aa:8,Rd | B | 2 | rd | abs | | | | | | | | | | | |
| | MOV.B @aa:16,Rd | B | 6 | A | 0 | rd | abs | | | | | | | | | |
| | MOV.B @aa:32,Rd | B | 6 | A | 2 | rd | abs | | | | | | | | | |
| | MOV.B Rs,@ERd | B | 6 | 8 | 1;erd | rs | | | | | | | | | | |
| | MOV.B Rs,@(d:16,ERd) | B | 6 | E | 1;erd | rs | disp | | | | | | | | | |
| | MOV.B Rs,@(d:32,ERd) | B | 7 | 8 | 0;erd | 0 | 6 | A | A | rs | disp | | | | | |
| | MOV.B Rs,@-ERd | B | 6 | C | 1;erd | rs | | | | | | | | | | |
| | MOV.B Rs,@aa:8 | B | 3 | rs | abs | | | | | | | | | | | |
| MOV.B Rs,@aa:16 | B | 6 | A | 8 | rs | abs | | | | | | | | | | |
| MOV.B Rs,@aa:32 | B | 6 | A | A | rs | abs | | | | | | | | | | |
| MOV.W #xx:16,Rd | MOV.W #xx:16,Rd | W | 7 | 9 | 0 | rd | IMM | | | | | | | | | |
| MOV.W Rs,Rd | MOV.W Rs,Rd | W | 0 | D | rs | rd | | | | | | | | | | |
| MOV.W @ERs,Rd | MOV.W @ERs,Rd | W | 6 | 9 | 0;ers | rd | | | | | | | | | | |
| MOV.W @(d:16,ERs),Rd | MOV.W @(d:16,ERs),Rd | W | 6 | F | 0;ers | rd | disp | | | | | | | | | |
| MOV.W @(d:32,ERs),Rd | MOV.W @(d:32,ERs),Rd | W | 7 | 8 | 0;ers | 0 | 6 | B | 2 | rd | disp | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | | |
|-------------------------------------|------------------------|--|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|-------|-------|------|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | | |
| MOV | MOV.W @ERS+,Rd | W | 6 | D | 0:ers | rd | | | | | | | | | | | | | | | |
| | MOV.W @aa:16,Rd | W | 6 | B | 0 | rd | abs | | | | | | | | | | | | | | |
| | MOV.W @aa:32,Rd | W | 6 | B | 2 | rd | abs | | | | | | | | | | | | | | |
| | MOV.W Rs,@ERd | W | 6 | 9 | 1:erd | rs | | | | | | | | | | | | | | | |
| | MOV.W Rs,@(d:16,ERd) | W | 6 | F | 1:erd | rs | disp | | | | | | | | | | | | | | |
| | MOV.W Rs,@(d:32,ERd) | W | 7 | 8 | 0:erd | 0 | 6 | B | A | rs | disp | | | | | | | | | | |
| | MOV.W Rs,@-ERd | W | 6 | D | 1:erd | rs | | | | | | | | | | | | | | | |
| | MOV.W Rs,@aa:16 | W | 6 | B | 8 | rs | abs | | | | | | | | | | | | | | |
| | MOV.W Rs,@aa:32 | W | 6 | B | A | rs | abs | | | | | | | | | | | | | | |
| | MOV.L #xx:32,Rd | L | 7 | A | 0 | 0:erd | | | | | | | | | | | | | | | |
| | MOV.L ERs,ERd | L | 0 | F | 1:ers | 0:erd | | | | | | | | | | | | | | | |
| | MOV.L @ERSs,ERd | L | 0 | 1 | 0 | 0 | 6 | 9 | 0:ers | 0:erd | | | | | | | | | | | |
| | MOV.L @(d:16,ERSs),ERd | L | 0 | 1 | 0 | 0 | 6 | F | 0:ers | 0:erd | disp | | | | | | | | | | |
| | MOV.L @(d:32,ERSs),ERd | L | 0 | 1 | 0 | 0 | 7 | 8 | 0:ers | 0 | 6 | B | 2 | 0:erd | disp | | | | | | |
| | MOV.L @ERSs+,ERd | L | 0 | 1 | 0 | 0 | 6 | D | 0:ers | 0:erd | | | | | | | | | | | |
| | MOV.L @aa:16,ERd | L | 0 | 1 | 0 | 0 | 6 | B | 0 | 0:erd | abs | | | | | | | | | | |
| | MOV.L @aa:32,ERd | L | 0 | 1 | 0 | 0 | 6 | B | 2 | 0:erd | abs | | | | | | | | | | |
| | MOV.L ERs,@ERd | L | 0 | 1 | 0 | 0 | 6 | 9 | 1:erd | 0:ers | | | | | | | | | | | |
| | MOV.L ERs,@(d:16,ERd) | L | 0 | 1 | 0 | 0 | 6 | F | 1:erd | 0:ers | disp | | | | | | | | | | |
| MOV.L ERs,@(d:32,ERd) ³¹ | L | 0 | 1 | 0 | 0 | 7 | 8 | 0:erd | 0 | 6 | B | A | 0:ers | disp | | | | | | | |
| MOV.L ERs,@-ERd | L | 0 | 1 | 0 | 0 | 6 | D | 1:erd | 0:ers | | | | | | | | | | | | |
| MOV.L ERs,@aa:16 | L | 0 | 1 | 0 | 0 | 6 | B | 8 | 0:ers | abs | | | | | | | | | | | |
| MOV.L ERs,@aa:32 | L | 0 | 1 | 0 | 0 | 6 | B | A | 0:ers | abs | | | | | | | | | | | |
| MOV.FPE @aa:16,Rd | B | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | | | | | | | | | | | | | | |
| MOV.TPE | MOV.TPE Rs,@aa:16 | B | | | | | | | | | | | | | | | | | | | |
| MULXS | MULXS.B Rs,Rd | B | 0 | 1 | C | 0 | 5 | 0 | rs | rd | | | | | | | | | | | |
| | MULXS.W Rs,ERd | W | 0 | 1 | C | 0 | 5 | 2 | rs | 0:erd | | | | | | | | | | | |
| MULXU | MULXU.B Rs,Rd | B | 5 | 0 | rs | rd | | | | | | | | | | | | | | | |
| | MULXU.W Rs,ERd | W | 5 | 2 | rs | 0:erd | | | | | | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|----------------|-----------------|---------------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| NEG | NEG.B Rd | B | 1 | 7 | 8 | rd | | | | | | | | | | | | | | |
| | NEG.W Rd | W | 1 | 7 | 9 | rd | | | | | | | | | | | | | | |
| | NEG.L ERd | L | 1 | 7 | B | 0:erd | | | | | | | | | | | | | | |
| NOP | NOP | — | 0 | 0 | 0 | 0 | | | | | | | | | | | | | | |
| NOT | NOT.B Rd | B | 1 | 7 | 0 | rd | | | | | | | | | | | | | | |
| | NOT.W Rd | W | 1 | 7 | 1 | rd | | | | | | | | | | | | | | |
| | NOT.L ERd | L | 1 | 7 | 3 | 0:erd | | | | | | | | | | | | | | |
| OR | OR.B #xx:8,Rd | B | C | rd | IMM | | | | | | | | | | | | | | | |
| | OR.B Rs,Rd | B | 1 | 4 | rs | rd | | | | | | | | | | | | | | |
| | OR.W #xx:16,Rd | W | 7 | 9 | 4 | rd | IMM | | | | | | | | | | | | | |
| | OR.W Rs,Rd | W | 6 | 4 | rs | rd | | | | | | | | | | | | | | |
| | OR.L #xx:32,ERd | L | 7 | A | 4 | 0:erd | | | | | | | | | | | | | | |
| | OR.L ERs,ERd | L | 0 | 1 | F | 0 | 6 | 4 | 0:ers | 0:erd | | | | | | | | | | |
| | ORC | ORC #xx:8,CCR | B | 0 | 4 | IMM | | | | | | | | | | | | | | |
| POP | POP #xx:8,EXR | B | 0 | 1 | 4 | 1 | 0 | 4 | IMM | | | | | | | | | | | |
| | POP.W Rn | W | 6 | D | 7 | rn | | | | | | | | | | | | | | |
| PUSH | POP.L ERn | L | 0 | 1 | 0 | 0 | 6 | D | 7 | 0:ern | | | | | | | | | | |
| | PUSH.W Rn | W | 6 | D | F | rn | | | | | | | | | | | | | | |
| | PUSH.L ERn | L | 0 | 1 | 0 | 0 | 6 | D | F | 0:ern | | | | | | | | | | |
| ROTL | ROTL.B Rd | B | 1 | 2 | 8 | rd | | | | | | | | | | | | | | |
| | ROTL.B #2, Rd | B | 1 | 2 | C | rd | | | | | | | | | | | | | | |
| | ROTL.W Rd | W | 1 | 2 | 9 | rd | | | | | | | | | | | | | | |
| | ROTL.W #2, Rd | W | 1 | 2 | D | rd | | | | | | | | | | | | | | |
| | ROTL.L ERd | L | 1 | 2 | B | 0:erd | | | | | | | | | | | | | | |
| ROTL.L #2, ERd | L | 1 | 2 | F | 0:erd | | | | | | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------|-----------------|------------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| ROTR | ROTR.B Rd | B | 1 | 3 | 8 | rd | | | | | | | | | | | | | | |
| | ROTR.B #2, Rd | B | 1 | 3 | C | rd | | | | | | | | | | | | | | |
| | ROTR.W Rd | W | 1 | 3 | 9 | rd | | | | | | | | | | | | | | |
| | ROTR.W #2, Rd | W | 1 | 3 | D | rd | | | | | | | | | | | | | | |
| | ROTR.L ERd | L | 1 | 3 | B | :0: erd | | | | | | | | | | | | | | |
| | ROTR.L #2, ERd | L | 1 | 3 | F | :0: erd | | | | | | | | | | | | | | |
| | ROTXL | ROTXL.B Rd | B | 1 | 2 | 0 | rd | | | | | | | | | | | | | |
| | ROTXL.B #2, Rd | B | 1 | 2 | 4 | rd | | | | | | | | | | | | | | |
| | ROTXL.W Rd | W | 1 | 2 | 1 | rd | | | | | | | | | | | | | | |
| | ROTXL.W #2, Rd | W | 1 | 2 | 5 | rd | | | | | | | | | | | | | | |
| | ROTXL.L ERd | L | 1 | 2 | 3 | :0: erd | | | | | | | | | | | | | | |
| | ROTXL.L #2, ERd | L | 1 | 2 | 7 | :0: erd | | | | | | | | | | | | | | |
| ROTXR | ROTXR.B Rd | B | 1 | 3 | 0 | rd | | | | | | | | | | | | | | |
| | ROTXR.B #2, Rd | B | 1 | 3 | 4 | rd | | | | | | | | | | | | | | |
| | ROTXR.W Rd | W | 1 | 3 | 1 | rd | | | | | | | | | | | | | | |
| | ROTXR.W #2, Rd | W | 1 | 3 | 5 | rd | | | | | | | | | | | | | | |
| | ROTXR.L ERd | L | 1 | 3 | 3 | :0: erd | | | | | | | | | | | | | | |
| | ROTXR.L #2, ERd | L | 1 | 3 | 7 | :0: erd | | | | | | | | | | | | | | |
| | RTE | RTE | — | 5 | 6 | 7 | 0 | | | | | | | | | | | | | |
| RTS | RTS | — | 5 | 4 | 7 | 0 | | | | | | | | | | | | | | |
| SHAL | SHAL.B Rd | B | 1 | 0 | 8 | rd | | | | | | | | | | | | | | |
| | SHAL.B #2, Rd | B | 1 | 0 | C | rd | | | | | | | | | | | | | | |
| | SHAL.W Rd | W | 1 | 0 | 9 | rd | | | | | | | | | | | | | | |
| | SHAL.W #2, Rd | W | 1 | 0 | D | rd | | | | | | | | | | | | | | |
| | SHAL.L ERd | L | 1 | 0 | B | :0: erd | | | | | | | | | | | | | | |
| | SHAL.L #2, ERd | L | 1 | 0 | F | :0: erd | | | | | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | | | | |
|-------------|-----------------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|---|---|--|--|--|--|--|------|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | | | | |
| SHAR | SHAR.B Rd | B | 1 | 1 | 8 | rd | | | | | | | | | | | | | | |
| | SHAR.B #2, Rd | B | 1 | 1 | C | rd | | | | | | | | | | | | | | |
| | SHAR.W Rd | W | 1 | 1 | 9 | rd | | | | | | | | | | | | | | |
| | SHAR.W #2, Rd | W | 1 | 1 | D | rd | | | | | | | | | | | | | | |
| | SHAR.L ERd | L | 1 | 1 | B | 0:erd | | | | | | | | | | | | | | |
| | SHAR.L #2, ERd | L | 1 | 1 | F | 0:erd | | | | | | | | | | | | | | |
| SHLL | SHLL.B Rd | B | 1 | 0 | 0 | rd | | | | | | | | | | | | | | |
| | SHLL.B #2, Rd | B | 1 | 0 | 4 | rd | | | | | | | | | | | | | | |
| | SHLL.W Rd | W | 1 | 0 | 1 | rd | | | | | | | | | | | | | | |
| | SHLL.W #2, Rd | W | 1 | 0 | 5 | rd | | | | | | | | | | | | | | |
| | SHLL.L ERd | L | 1 | 0 | 3 | 0:erd | | | | | | | | | | | | | | |
| | SHLL.L #2, ERd | L | 1 | 0 | 7 | 0:erd | | | | | | | | | | | | | | |
| SHLR | SHLR.B Rd | B | 1 | 1 | 0 | rd | | | | | | | | | | | | | | |
| | SHLR.B #2, Rd | B | 1 | 1 | 4 | rd | | | | | | | | | | | | | | |
| | SHLR.W Rd | W | 1 | 1 | 1 | rd | | | | | | | | | | | | | | |
| | SHLR.W #2, Rd | W | 1 | 1 | 5 | rd | | | | | | | | | | | | | | |
| | SHLR.L ERd | L | 1 | 1 | 3 | 0:erd | | | | | | | | | | | | | | |
| | SHLR.L #2, ERd | L | 1 | 1 | 7 | 0:erd | | | | | | | | | | | | | | |
| SLEEP | SLEEP | — | 0 | 1 | 8 | 0 | | | | | | | | | | | | | | |
| STC | STC.B CCR,Rd | B | 0 | 2 | 0 | rd | | | | | | | | | | | | | | |
| | STC.B EXR,Rd | B | 0 | 2 | 1 | rd | | | | | | | | | | | | | | |
| | STC.W CCR,@ERd | W | 0 | 1 | 4 | 0 | 6 | 9 | 1:erd | 0 | | | | | | | | | | |
| | STC.W EXR,@ERd | W | 0 | 1 | 4 | 1 | 6 | 9 | 1:erd | 0 | | | | | | | | | | |
| | STC.W CCR,@(d:16,ERd) | W | 0 | 1 | 4 | 0 | 6 | F | 1:erd | 0 | | | | | | | | | | |
| | STC.W EXR,@(d:16,ERd) | W | 0 | 1 | 4 | 1 | 6 | F | 1:erd | 0 | | | | | | | | | | |
| | STC.W CCR,@(d:32,ERd) | W | 0 | 1 | 4 | 0 | 7 | 8 | 0:erd | 0 | 6 | B | A | 0 | | | | | | disp |
| | STC.W EXR,@(d:32,ERd) | W | 0 | 1 | 4 | 1 | 7 | 8 | 0:erd | 0 | 6 | B | A | 0 | | | | | | disp |
| | STC.W CCR,@-ERd | W | 0 | 1 | 4 | 0 | 6 | D | 1:erd | 0 | | | | | | | | | | |
| | STC.W EXR,@-ERd | W | 0 | 1 | 4 | 1 | 6 | D | 1:erd | 0 | | | | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | | |
|-------------|-------------------------|----------------|--------------------|--|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|--|
| | | | 1st Byte | 2nd Byte | 3rd Byte | 4th Byte | 5th Byte | 6th Byte | 7th Byte | 8th Byte | 9th Byte | 10th Byte | | | | | |
| STC | STC.W COR, @aa:16 | W | 0 | 1 | 4 | 0 | 6 | B | 8 | 0 | abs | | | | | | |
| | STC.W EXR, @aa:16 | W | 0 | 1 | 4 | 1 | 6 | B | 8 | 0 | abs | | | | | | |
| | STC.W COR, @aa:32 | W | 0 | 1 | 4 | 0 | 6 | B | A | 0 | abs | | | | | | |
| | STC.W EXR, @aa:32 | W | 0 | 1 | 4 | 1 | 6 | B | A | 0 | abs | | | | | | |
| STM#3 | STM.L (ERn-ERn+1), @-SP | L | 0 | 1 | 1 | 0 | 6 | D | F | 0:ern | | | | | | | |
| | STM.L (ERn-ERn+2), @-SP | L | 0 | 1 | 2 | 0 | 6 | D | F | 0:ern | | | | | | | |
| | STM.L (ERn-ERn+3), @-SP | L | 0 | 1 | 3 | 0 | 6 | D | F | 0:ern | | | | | | | |
| | STMAC | STMAC MACL,ERd | L | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | | | | | | | | |
| SUB | STMAC MACL,ERd | L | | | | | | | | | | | | | | | |
| | SUB.B Rs,Rd | B | 1 | 8 | rs | rd | | | | | | | | | | | |
| | SUB.W #xx:16,Rd | W | 7 | 9 | 3 | rd | IMM | | | | | | | | | | |
| | SUB.W Rs,Rd | W | 1 | 9 | rs | rd | | | | | | | | | | | |
| | SUB.L #xx:32,ERd | L | 7 | A | 3 | 0:erd | IMM | | | | | | | | | | |
| | SUB.L ERs,ERd | L | 1 | A | 1:ers | 0:erd | | | | | | | | | | | |
| | SUBS #1,ERd | L | 1 | B | 0 | 0:erd | | | | | | | | | | | |
| | SUBS #2,ERd | L | 1 | B | 8 | 0:erd | | | | | | | | | | | |
| | SUBS #4,ERd | L | 1 | B | 9 | 0:erd | | | | | | | | | | | |
| | SUBX | SUBX #xx:8,Rd | B | B | rd | IMM | | | | | | | | | | | |
| TAS | SUBX Rs,Rd | B | 1 | E | rs | rd | | | | | | | | | | | |
| | TAS @ERd#2 | B | 0 | 1 | E | 0 | 7 | B | 0:erd | C | | | | | | | |
| TRAPA | TRAPA #x:2 | — | 5 | 7 | 00:IMM | 0 | | | | | | | | | | | |
| XOR | XOR.B #xx:8,Rd | B | D | rd | IMM | | | | | | | | | | | | |
| | XOR.B Rs,Rd | B | 1 | 5 | rs | rd | | | | | | | | | | | |
| | XOR.W #xx:16,Rd | W | 7 | 9 | 5 | rd | IMM | | | | | | | | | | |
| | XOR.W Rs,Rd | W | 6 | 5 | rs | rd | | | | | | | | | | | |
| XOR.L | XOR.L #xx:32,ERd | L | 7 | A | 5 | 0:erd | IMM | | | | | | | | | | |
| | XOR.L ERs,ERd | L | 0 | 1 | F | 0 | 6 | 5 | 0:ers | 0:erd | | | | | | | |

| Instruction | Mnemonic | Size | Instruction Format | | | | | | | | | | | | | |
|-------------|----------------|------|--------------------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|--|--|--|--|
| | | | 1st byte | 2nd byte | 3rd byte | 4th byte | 5th byte | 6th byte | 7th byte | 8th byte | 9th byte | 10th byte | | | | |
| XORC | XORC #xx:8:CCR | B | 0 | 5 | IMM | | | | | | | | | | | |
| | XORC #xx:8:EXR | B | 0 | 1 | 4 | 1 | 0 | 5 | IMM | | | | | | | |

- Notes: 1. Bit 7 of the 4th byte of the MOV.L ERs, @ (d:32, ERd) instruction can be either 0 or 1.
 2. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
 3. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

Legend:

IMM: Immediate data (2, 3, 8, 16, or 32 bits)

abs: Absolute address (8, 16, 24, or 32 bits)

disp: Displacement (8, 16, or 32 bits)

rs, rd, rn: Register field (4 bits, indicating an 8-bit or 16-bit register. rs, rd, and rn correspond to operand formats Rs, Rd, and Rn, respectively.)
 ers, erd, ern, erm: Register field (3 bits, indicating an address register or 32-bit register. ers, erd, ern, and erm correspond to operand formats ERs, ERd, ERn, and ERm, respectively.)

The correspondence between register fields and general registers is shown in the following table.

| Address Registers | | 16-Bit Register | | 8-Bit Register | |
|-------------------|------------------|-----------------|------------------|----------------|------------------|
| 32-Bit Registers | General Register | Register Field | General Register | Register Field | General Register |
| 000 | ER0 | 0000 | R0 | 0000 | R0H |
| 001 | ER1 | 0001 | R1 | 0001 | R1H |
| • | • | • | • | • | • |
| • | • | • | • | • | • |
| • | • | • | • | • | • |
| 111 | ER7 | 0111 | R7 | 0111 | R7H |
| | | 1000 | E0 | 1000 | R0L |
| | | 1001 | E1 | 1001 | R1L |
| | | • | • | • | • |
| | | • | • | • | • |
| | | • | • | • | • |
| | | 1111 | E7 | 1111 | R7L |

A.3 Operation Code Map

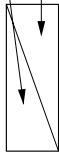
Table A.3 shows the operation code map.

Table A.3 Operation Code Map (1)

| Instruction code: | | 1st byte | | 2nd byte | | | | | | | | | | | | | | | |
|-------------------|----|----------------------|----------------------|----------------|----------------|----------------|-----------------|-----------------|----------------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|---------------|---------------|
| AH | AL | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F | | |
| | 0 | NOP Table A.3 (2) | STC Table A.3 (2) | STC * STMAC | LDC * LDMAC | ORC | XORC | ANDC | LDC Table A.3 (2) | ADD | ADD | Table A.3 (2) | Table A.3 (2) | Table A.3 (2) | MOV | ADDD | Table A.3 (2) | | |
| | 1 | Table A.3 (2) | Table A.3 (2) | Table A.3 (2) | Table A.3 (2) | OR | XOR | AND | Table A.3 (2) | SUB | SUB | Table A.3 (2) | Table A.3 (2) | CMP | CMP | SUBX | Table A.3 (2) | | |
| | 2 | MOV/B | | | | | | | | | | | | | | | | | |
| | 3 | MOV/B | | | | | | | | | | | | | | | | | |
| | 4 | BRA | BRN | BHI | BLS | BCC | BCS | BNE | BEQ | BVC | BVS | BPL | BMI | BGE | BLT | BGT | BLE | | |
| | 5 | MULXU | DIVXU | MULXU | DIVXU | RTS | BSR | RTE | TRAPA | Table A.3 (2) | Table A.3 (2) | JMP | | BSR | | JSR | | | |
| | 6 | BSET | BNOT | BCLR | BTST | BOR | BXOR | AND | BST | MOV | MOV | Table A.3 (2) | | | | | | | |
| | 7 | | | | | BOR | BXOR | BAND | BLD | BAND | BAND | BAND | BAND | BAND | BAND | BAND | BAND | Table A.3 (2) | Table A.3 (3) |
| | 8 | ADD | | | | | | | | | | | | | | | | | |
| | 9 | ADDD | | | | | | | | | | | | | | | | | |
| | A | CMP | | | | | | | | | | | | | | | | | |
| | B | SUBX | | | | | | | | | | | | | | | | | |
| | C | OR | | | | | | | | | | | | | | | | | |
| | D | XOR | | | | | | | | | | | | | | | | | |
| | E | AND | | | | | | | | | | | | | | | | | |
| | F | MOV | | | | | | | | | | | | | | | | | |

Note: * Cannot be used with the H8S/2138 Group and H8S/2134 Group.

Instruction when most significant bit of BH is 0.



Instruction when most significant bit of BH is 1.

Table A.3 Operation Code Map (2)

| | | | |
|----------|----|----------|----|
| 1st byte | | 2nd byte | |
| AH | AL | BH | BL |

Instruction code:

| BH | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
|------|-------|--------------|-----|--------------|--------|-----|------|-------|-------|-----|---------|-----|--------------|--------------|--------------|--------------|
| AHAL | MOV | LDM | STM | LDC | STC | | MAC* | | SLEEP | | CLRMAC* | | Table A.3(3) | Table A.3(3) | Table A.3(3) | Table A.3(3) |
| 0A | INC | ADD | | | | | | | | | | | | | | |
| 0B | ADDS | | | | | INC | | INC | ADDS | | | | | INC | | INC |
| 0F | DAA | MOV | | | | | | | | | | | | | | |
| 10 | SHLL | | | SHLL | | | | SHLL | SHAL | | | | SHAL | | | SHAL |
| 11 | SHLR | | | SHLR | | | | SHLR | SHAR | | | | SHAR | | | SHAR |
| 12 | ROTXL | | | ROTXL | | | | ROTXL | ROTL | | | | ROTL | | | ROTL |
| 13 | ROTXR | | | ROTXR | | | | ROTXR | ROTR | | | | ROTR | | | ROTR |
| 17 | NOT | | | NOT | | | | EXTU | NEG | | | NEG | | EXTS | | EXTS |
| 1A | DEC | SUB | | | | | | | | | | | | | | |
| 1B | SUBS | | | | | DEC | | DEC | SUBS | | | | | DEC | | DEC |
| 1F | DAS | CMP | | | | | | | | | | | | | | |
| 58 | BRA | BRN | BHI | BLS | BCC | BCS | BNE | BEQ | BVC | BVS | BPL | BMI | BGE | BLT | BGT | BLE |
| 6A | MOV | Table A.3(4) | MOV | Table A.3(4) | MOVFP* | | | | MOV | | MOV | | MOV* | | | |
| 79 | MOV | ADD | CMP | SUB | OR | XOR | AND | | | | | | | | | |
| 7A | MOV | ADD | CMP | SUB | OR | XOR | AND | | | | | | | | | |

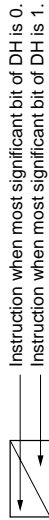
Note: * Cannot be used with the H8S/2138 Group and H8S/2134 Group.



Table A.3 Operation Code Map (3)

Instruction code:

| 1st byte | | 2nd byte | | 3rd byte | | 4th byte | |
|----------|----|----------|----|----------|----|----------|----|
| AH | AL | BH | BL | CH | CL | DH | DL |



| | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
|---------------------|-------|-------|------|-------|-----|------|------|-----|------|-------|-------|------|------|---|---|---|
| AH\AL\BH\CH | CL | | | | | | | | | | | | | | | |
| 01C05 | MULXS | MULXS | | | | | | | | | | | | | | |
| 01D05 | | DIVXS | | DIVXS | | | | | | | | | | | | |
| 01F06 | | | | | OR | XOR | AND | | | | | | | | | |
| 7Cr06* ¹ | | | | BTST | | | | | | | | | | | | |
| 7Cr07* ¹ | | | | BTST | BOB | BXOR | BAND | BLD | BIOR | BIXOR | BIAND | BILD | BIST | | | |
| 7Dr06* ¹ | BSET | BNOT | BCLR | | | | | | | | | | | | | |
| 7Dr07* ¹ | BSET | BNOT | BCLR | | | | | | | | | | | | | |
| 7Eaa6* ² | | | | BTST | | | | | | | | | | | | |
| 7Eaa7* ² | | | | BTST | BOB | BXOR | BAND | BLD | BIOR | BIXOR | BIAND | BILD | BIST | | | |
| 7Faa6* ² | BSET | BNOT | BCLR | | | | | | | | | | | | | |
| 7Faa7* ² | BSET | BNOT | BCLR | | | | | | | | | | | | | |

Notes: 1. r is the register specification field.
2. aa is the absolute address specification.

A.4 Number of States Required for Execution

The tables in this section can be used to calculate the number of states required for instruction execution by the H8S/2000 CPU. Table A.5 shows the number of instruction fetch, data read/write, and other cycles occurring in each instruction, and table A.4 shows the number of states required per cycle according to the bus size. The number of states required for execution of an instruction can be calculated from these two tables as follows:

$$\text{Number of states} = I \times S_I + J \times S_J + K \times S_K + L \times S_L + M \times S_M + N \times S_N$$

Examples of Calculation of Number of States Required for Execution

Examples: Advanced mode, stack located in external address space, on-chip supporting modules accessed in two states with 8-bit bus width, external devices accessed in three states with one wait state and 8-bit bus width.

1. BSET #0,@FFFFC7:8

From table A.5, $I = L = 2$ and $J = K = M = N = 0$

From table A.4, $S_I = 8$ and $S_L = 2$

Number of states = $2 \times 8 + 2 \times 2 = 20$

2. JSR @@30

From table A.5, $I = J = K = 2$ and $L = M = N = 0$

From table A.4, $S_I = S_J = S_K = 8$

Number of states = $2 \times 8 + 2 \times 8 + 2 \times 8 = 48$

Table A.4 Number of States per Cycle

| Cycle | | Access Conditions | | | | | | |
|----------------------|-------|-------------------|---------------------------------|-------------------|-------------------|-------------------|-------------------|-------|
| | | On-Chip Memory | On-Chip Supporting Module | | External Device | | | |
| | | | 8-Bit Bus | 16-Bit Bus | 8-Bit Bus | | 16-Bit Bus* | |
| | | | | 2-State Access | 3-State Access | 2-State Access | 3-State Access | |
| Instruction fetch | S_I | 1 | 4 | 2 | 4 | 6 + 2m | 2 | 3 + m |
| Branch address fetch | S_J | | | | | | | |
| Stack operation | S_K | | | | | | | |
| Byte data access | S_L | | 2 | | 2 | 3 + m | | |
| Word data access | S_M | | 4 | | 4 | 6 + 2m | | |
| Internal operation | S_N | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Legend:

m: Number of wait states inserted into external device access

Note: Cannot be used in the H8S/2138 Group and H8S/2134 Group.

Table A.5 Number of Cycles per Instruction

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|-------------------|-------------|----------------------|----------------|-------------|-------------|----------------|
| | | Fetch I | Address Read J | Operation K | Access L | Access M | Operation N |
| ADD | ADD.B #xx:8,Rd | 1 | | | | | |
| | ADD.B Rs,Rd | 1 | | | | | |
| | ADD.W #xx:16,Rd | 2 | | | | | |
| | ADD.W Rs,Rd | 1 | | | | | |
| | ADD.L #xx:32,ERd | 3 | | | | | |
| | ADD.L ERs,ERd | 1 | | | | | |
| ADDS | ADDS #1/2/4,ERd | 1 | | | | | |
| ADDX | ADDX #xx:8,Rd | 1 | | | | | |
| | ADDX Rs,Rd | 1 | | | | | |
| AND | AND.B #xx:8,Rd | 1 | | | | | |
| | AND.B Rs,Rd | 1 | | | | | |
| | AND.W #xx:16,Rd | 2 | | | | | |
| | AND.W Rs,Rd | 1 | | | | | |
| | AND.L #xx:32,ERd | 3 | | | | | |
| | AND.L ERs,ERd | 2 | | | | | |
| ANDC | ANDC #xx:8,CCR | 1 | | | | | |
| | ANDC #xx:8,EXR | 2 | | | | | |
| BAND | BAND #xx:3,Rd | 1 | | | | | |
| | BAND #xx:3,@ERd | 2 | | | 1 | | |
| | BAND #xx:3,@aa:8 | 2 | | | 1 | | |
| | BAND #xx:3,@aa:16 | 3 | | | 1 | | |
| | BAND #xx:3,@aa:32 | 4 | | | 1 | | |
| Bcc | BRA d:8 (BT d:8) | 2 | | | | | |
| | BRN d:8 (BF d:8) | 2 | | | | | |
| | BHI d:8 | 2 | | | | | |
| | BLS d:8 | 2 | | | | | |
| | BCC d:8 (BHS d:8) | 2 | | | | | |
| | BCS d:8 (BLO d:8) | 2 | | | | | |
| | BNE d:8 | 2 | | | | | |
| | BEQ d:8 | 2 | | | | | |
| | BVC d:8 | 2 | | | | | |
| | BVS d:8 | 2 | | | | | |
| | BPL d:8 | 2 | | | | | |
| | BMI d:8 | 2 | | | | | |

| Instruction | Mnemonic | Instruction Fetch I | Branch | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|----------------|---------------------|---------------------------|----------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| | | | Address Read J | | | | |
| Bcc | BGE d:8 | 2 | | | | | |
| | BLT d:8 | 2 | | | | | |
| | BGT d:8 | 2 | | | | | |
| | BLE d:8 | 2 | | | | | |
| | BRA d:16 (BT d:16) | 2 | | | | | 1 |
| | BRN d:16 (BF d:16) | 2 | | | | | 1 |
| | BHI d:16 | 2 | | | | | 1 |
| | BLS d:16 | 2 | | | | | 1 |
| | BCC d:16 (BHS d:16) | 2 | | | | | 1 |
| | BCS d:16 (BLO d:16) | 2 | | | | | 1 |
| | BNE d:16 | 2 | | | | | 1 |
| | BEQ d:16 | 2 | | | | | 1 |
| | BVC d:16 | 2 | | | | | 1 |
| | BVS d:16 | 2 | | | | | 1 |
| | BPL d:16 | 2 | | | | | 1 |
| | BMI d:16 | 2 | | | | | 1 |
| | BGE d:16 | 2 | | | | | 1 |
| | BLT d:16 | 2 | | | | | 1 |
| BGT d:16 | 2 | | | | | 1 | |
| BLE d:16 | 2 | | | | | 1 | |
| BCLR | BCLR #xx:3,Rd | 1 | | | | | |
| | BCLR #xx:3,@ERd | 2 | | | 2 | | |
| | BCLR #xx:3,@aa:8 | 2 | | | 2 | | |
| | BCLR #xx:3,@aa:16 | 3 | | | 2 | | |
| | BCLR #xx:3,@aa:32 | 4 | | | 2 | | |
| | BCLR Rn,Rd | 1 | | | | | |
| | BCLR Rn,@ERd | 2 | | | 2 | | |
| | BCLR Rn,@aa:8 | 2 | | | 2 | | |
| | BCLR Rn,@aa:16 | 3 | | | 2 | | |
| BCLR Rn,@aa:32 | 4 | | | 2 | | | |
| BIAND | BIAND #xx:3,Rd | 1 | | | | | |
| | BIAND #xx:3,@ERd | 2 | | | 1 | | |
| | BIAND #xx:3,@aa:8 | 2 | | | 1 | | |
| | BIAND #xx:3,@aa:16 | 3 | | | 1 | | |
| | BIAND #xx:3,@aa:32 | 4 | | | 1 | | |

| Instruction | Mnemonic | Instruction Fetch | Branch Address | | Stack Operation | Byte Data Access | Word Data Access | Internal Operation |
|----------------|--------------------|----------------------|-------------------|---|--------------------|---------------------|---------------------|-----------------------|
| | | | I | J | | | | |
| BILD | BILD #xx:3,Rd | 1 | | | | | | |
| | BILD #xx:3,@ERd | 2 | | | | 1 | | |
| | BILD #xx:3,@aa:8 | 2 | | | | 1 | | |
| | BILD #xx:3,@aa:16 | 3 | | | | 1 | | |
| | BILD #xx:3,@aa:32 | 4 | | | | 1 | | |
| BIOR | BIOR #xx:8,Rd | 1 | | | | | | |
| | BIOR #xx:8,@ERd | 2 | | | | 1 | | |
| | BIOR #xx:8,@aa:8 | 2 | | | | 1 | | |
| | BIOR #xx:8,@aa:16 | 3 | | | | 1 | | |
| | BIOR #xx:8,@aa:32 | 4 | | | | 1 | | |
| BIST | BIST #xx:3,Rd | 1 | | | | | | |
| | BIST #xx:3,@ERd | 2 | | | | 2 | | |
| | BIST #xx:3,@aa:8 | 2 | | | | 2 | | |
| | BIST #xx:3,@aa:16 | 3 | | | | 2 | | |
| | BIST #xx:3,@aa:32 | 4 | | | | 2 | | |
| BIXOR | BIXOR #xx:3,Rd | 1 | | | | | | |
| | BIXOR #xx:3,@ERd | 2 | | | | 1 | | |
| | BIXOR #xx:3,@aa:8 | 2 | | | | 1 | | |
| | BIXOR #xx:3,@aa:16 | 3 | | | | 1 | | |
| | BIXOR #xx:3,@aa:32 | 4 | | | | 1 | | |
| BLD | BLD #xx:3,Rd | 1 | | | | | | |
| | BLD #xx:3,@ERd | 2 | | | | 1 | | |
| | BLD #xx:3,@aa:8 | 2 | | | | 1 | | |
| | BLD #xx:3,@aa:16 | 3 | | | | 1 | | |
| | BLD #xx:3,@aa:32 | 4 | | | | 1 | | |
| BNOT | BNOT #xx:3,Rd | 1 | | | | | | |
| | BNOT #xx:3,@ERd | 2 | | | | 2 | | |
| | BNOT #xx:3,@aa:8 | 2 | | | | 2 | | |
| | BNOT #xx:3,@aa:16 | 3 | | | | 2 | | |
| | BNOT #xx:3,@aa:32 | 4 | | | | 2 | | |
| | BNOT Rn,Rd | 1 | | | | | | |
| | BNOT Rn,@ERd | 2 | | | | 2 | | |
| | BNOT Rn,@aa:8 | 2 | | | | 2 | | |
| | BNOT Rn,@aa:16 | 3 | | | | 2 | | |
| BNOT Rn,@aa:32 | 4 | | | | 2 | | | |

| Instruction | Mnemonic | Instruction Fetch I | Branch | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|----------------|-------------------|---------------------------|----------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| | | | Address Read J | | | | |
| BOR | BOR #xx:3,Rd | 1 | | | | | |
| | BOR #xx:3,@ERd | 2 | | | 1 | | |
| | BOR #xx:3,@aa:8 | 2 | | | 1 | | |
| | BOR #xx:3,@aa:16 | 3 | | | 1 | | |
| | BOR #xx:3,@aa:32 | 4 | | | 1 | | |
| BSET | BSET #xx:3,Rd | 1 | | | | | |
| | BSET #xx:3,@ERd | 2 | | | 2 | | |
| | BSET #xx:3,@aa:8 | 2 | | | 2 | | |
| | BSET #xx:3,@aa:16 | 3 | | | 2 | | |
| | BSET #xx:3,@aa:32 | 4 | | | 2 | | |
| | BSET Rn,Rd | 1 | | | | | |
| | BSET Rn,@ERd | 2 | | | 2 | | |
| | BSET Rn,@aa:8 | 2 | | | 2 | | |
| | BSET Rn,@aa:16 | 3 | | | 2 | | |
| BSET Rn,@aa:32 | 4 | | | 2 | | | |
| BSR | BSR d:8 | Normal | 2 | | 1 | | |
| | | Advanced | 2 | | 2 | | |
| | BSR d:16 | Normal | 2 | | 1 | | 1 |
| | | Advanced | 2 | | 2 | | 1 |
| BST | BST #xx:3,Rd | 1 | | | | | |
| | BST #xx:3,@ERd | 2 | | | 2 | | |
| | BST #xx:3,@aa:8 | 2 | | | 2 | | |
| | BST #xx:3,@aa:16 | 3 | | | 2 | | |
| | BST #xx:3,@aa:32 | 4 | | | 2 | | |
| BTST | BTST #xx:3,Rd | 1 | | | | | |
| | BTST #xx:3,@ERd | 2 | | | 1 | | |
| | BTST #xx:3,@aa:8 | 2 | | | 1 | | |
| | BTST #xx:3,@aa:16 | 3 | | | 1 | | |
| | BTST #xx:3,@aa:32 | 4 | | | 1 | | |
| | BTST Rn,Rd | 1 | | | | | |
| | BTST Rn,@ERd | 2 | | | 1 | | |
| | BTST Rn,@aa:8 | 2 | | | 1 | | |
| | BTST Rn,@aa:16 | 3 | | | 1 | | |
| | BTST Rn,@aa:32 | 4 | | | 1 | | |

| Instruction | Mnemonic | Branch | | | | | | |
|-------------|-------------------|--|--------------|-----------------|------------------|------------------|--------------------|---|
| | | Instruction Fetch | Address Read | Stack Operation | Byte Data Access | Word Data Access | Internal Operation | |
| | | I | J | K | L | M | N | |
| BXOR | BXOR #xx:3,Rd | 1 | | | | | | |
| | BXOR #xx:3,@ERd | 2 | | | 1 | | | |
| | BXOR #xx:3,@aa:8 | 2 | | | 1 | | | |
| | BXOR #xx:3,@aa:16 | 3 | | | 1 | | | |
| | BXOR #xx:3,@aa:32 | 4 | | | 1 | | | |
| CLRMAC | CLRMAC | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | |
| CMP | CMP.B #xx:8,Rd | 1 | | | | | | |
| | CMP.B Rs,Rd | 1 | | | | | | |
| | CMP.W #xx:16,Rd | 2 | | | | | | |
| | CMP.W Rs,Rd | 1 | | | | | | |
| | CMP.L #xx:32,ERd | 3 | | | | | | |
| | CMP.L ERs,ERd | 1 | | | | | | |
| DAA | DAA Rd | 1 | | | | | | |
| DAS | DAS Rd | 1 | | | | | | |
| DEC | DEC.B Rd | 1 | | | | | | |
| | DEC.W #1/2,Rd | 1 | | | | | | |
| | DEC.L #1/2,ERd | 1 | | | | | | |
| DIVXS | DIVXS.B Rs,Rd | 2 | | | | | 11 | |
| | DIVXS.W Rs,ERd | 2 | | | | | 19 | |
| DIVXU | DIVXU.B Rs,Rd | 1 | | | | | 11 | |
| | DIVXU.W Rs,ERd | 1 | | | | | 19 | |
| EEPMOV | EEPMOV.B | 2 | | | $2n+2^{3z}$ | | | |
| | EEPMOV.W | 2 | | | $2n+2^{3z}$ | | | |
| EXTS | EXTS.W Rd | 1 | | | | | | |
| | EXTS.L ERd | 1 | | | | | | |
| EXTU | EXTU.W Rd | 1 | | | | | | |
| | EXTU.L ERd | 1 | | | | | | |
| INC | INC.B Rd | 1 | | | | | | |
| | INC.W #1/2,Rd | 1 | | | | | | |
| | INC.L #1/2,ERd | 1 | | | | | | |
| JMP | JMP @ERn | 2 | | | | | | |
| | JMP @aa:24 | 2 | | | | | 1 | |
| | JMP @@aa:8 | Normal | 2 | 1 | | | | 1 |
| | | Advanced | 2 | 2 | | | | 1 |

| Instruction | Mnemonic | | Branch | | | | | |
|-------------------|-------------------------|--|------------------------|-------------------|----------------------|-----------------------|-----------------------|-------------------------|
| | | | Instruction Fetch I | Address Read J | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
| JSR | JSR @ERn | Normal | 2 | | 1 | | | |
| | | Advanced | 2 | | 2 | | | |
| | JSR @aa:24 | Normal | 2 | | 1 | | | 1 |
| | | Advanced | 2 | | 2 | | | 1 |
| | JSR @@aa:8 | Normal | 2 | 1 | 1 | | | |
| | | Advanced | 2 | 2 | 2 | | | |
| LDC | LDC #xx:8,CCR | | 1 | | | | | |
| | LDC #xx:8,EXR | | 2 | | | | | |
| | LDC Rs,CCR | | 1 | | | | | |
| | LDC Rs,EXR | | 1 | | | | | |
| | LDC @ERs,CCR | | 2 | | | | 1 | |
| | LDC @ERs,EXR | | 2 | | | | 1 | |
| | LDC @(d:16,ERs),CCR | | 3 | | | | 1 | |
| | LDC @(d:16,ERs),EXR | | 3 | | | | 1 | |
| | LDC @(d:32,ERs),CCR | | 5 | | | | 1 | |
| | LDC @(d:32,ERs),EXR | | 5 | | | | 1 | |
| | LDC @ERs+,CCR | | 2 | | | | 1 | 1 |
| | LDC @ERs+,EXR | | 2 | | | | 1 | 1 |
| | LDC @aa:16,CCR | | 3 | | | | 1 | |
| | LDC @aa:16,EXR | | 3 | | | | 1 | |
| | LDC @aa:32,CCR | | 4 | | | | 1 | |
| | LDC @aa:32,EXR | | 4 | | | | 1 | |
| LDM ^{*4} | LDM.L @SP+, (ERn-ERn+1) | | 2 | | 4 | | | 1 |
| | LDM.L @SP+, (ERn-ERn+2) | | 2 | | 6 | | | 1 |
| | LDM.L @SP+, (ERn-ERn+3) | | 2 | | 8 | | | 1 |
| LDMAC | LDMAC ERs, MACH | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | |
| | LDMAC ERs, MACL | | | | | | | |
| MAC | MAC @ERn+, @ERm+ | | | | | | | |
| MOV | MOV.B #xx:8,Rd | | 1 | | | | | |
| | MOV.B Rs,Rd | | 1 | | | | | |
| | MOV.B @ERs,Rd | | 1 | | | 1 | | |
| | MOV.B @(d:16,ERs),Rd | | 2 | | | 1 | | |
| | MOV.B @(d:32,ERs),Rd | | 4 | | | 1 | | |
| | MOV.B @ERs+,Rd | | 1 | | | 1 | | 1 |
| | MOV.B @aa:8,Rd | | 1 | | | 1 | | |
| | MOV.B @aa:16,Rd | | 2 | | | 1 | | |

| Instruction | Mnemonic | Instruction Fetch | Branch Address | | | Stack Operation | Byte Data Access | Word Data Access | Internal Operation |
|-------------|-----------------------|----------------------|-------------------|---|---|--------------------|---------------------|---------------------|-----------------------|
| | | | I | J | K | | | | |
| MOV | MOV.B @aa:32,Rd | 3 | | | | 1 | | | |
| | MOV.B Rs,@ERd | 1 | | | | 1 | | | |
| | MOV.B Rs,@(d:16,ERd) | 2 | | | | 1 | | | |
| | MOV.B Rs,@(d:32,ERd) | 4 | | | | 1 | | | |
| | MOV.B Rs,@-ERd | 1 | | | | 1 | | | 1 |
| | MOV.B Rs,@aa:8 | 1 | | | | 1 | | | |
| | MOV.B Rs,@aa:16 | 2 | | | | 1 | | | |
| | MOV.B Rs,@aa:32 | 3 | | | | 1 | | | |
| | MOV.W #xx:16,Rd | 2 | | | | | | | |
| | MOV.W Rs,Rd | 1 | | | | | | | |
| | MOV.W @ERs,Rd | 1 | | | | | 1 | | |
| | MOV.W @(d:16,ERs),Rd | 2 | | | | | 1 | | |
| | MOV.W @(d:32,ERs),Rd | 4 | | | | | 1 | | |
| | MOV.W @ERs+,Rd | 1 | | | | | 1 | | 1 |
| | MOV.W @aa:16,Rd | 2 | | | | | 1 | | |
| | MOV.W @aa:32,Rd | 3 | | | | | 1 | | |
| | MOV.W Rs,@ERd | 1 | | | | | 1 | | |
| | MOV.W Rs,@(d:16,ERd) | 2 | | | | | 1 | | |
| | MOV.W Rs,@(d:32,ERd) | 4 | | | | | 1 | | |
| | MOV.W Rs,@-ERd | 1 | | | | | 1 | | 1 |
| | MOV.W Rs,@aa:16 | 2 | | | | | 1 | | |
| | MOV.W Rs,@aa:32 | 3 | | | | | 1 | | |
| | MOV.L #xx:32,ERd | 3 | | | | | | | |
| | MOV.L ERs,ERd | 1 | | | | | | | |
| | MOV.L @ERs,ERd | 2 | | | | | 2 | | |
| | MOV.L @(d:16,ERs),ERd | 3 | | | | | 2 | | |
| | MOV.L @(d:32,ERs),ERd | 5 | | | | | 2 | | |
| | MOV.L @ERs+,ERd | 2 | | | | | 2 | | 1 |
| | MOV.L @aa:16,ERd | 3 | | | | | 2 | | |
| | MOV.L @aa:32,ERd | 4 | | | | | 2 | | |
| | MOV.L ERs,@ERd | 2 | | | | | 2 | | |
| | MOV.L ERs,@(d:16,ERd) | 3 | | | | | 2 | | |
| | MOV.L ERs,@(d:32,ERd) | 5 | | | | | 2 | | |
| | MOV.L ERs,@-ERd | 2 | | | | | 2 | | 1 |
| | MOV.L ERs,@aa:16 | 3 | | | | | 2 | | |
| | MOV.L ERs,@aa:32 | 4 | | | | | 2 | | |

| Instruction | Mnemonic | Instruction Fetch I | Branch | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N | |
|-------------|------------------|--|----------------------|-------------------------|--------------------------|--------------------------|----------------------------|--|
| | | | Address Read J | | | | | |
| MOVFP | MOVFP @:aa:16,Rd | Cannot be used with the H8S/2138 Group and H8S/2134 Group. | | | | | | |
| MOVTP | MOVTP Rs,@:aa:16 | | | | | | | |
| MULXS | MULXS.B Rs,Rd | 2 | | | | | 11 | |
| | MULXS.W Rs,ERd | 2 | | | | | 19 | |
| MULXU | MULXU.B Rs,Rd | 1 | | | | | 11 | |
| | MULXU.W Rs,ERd | 1 | | | | | 19 | |
| NEG | NEG.B Rd | 1 | | | | | | |
| | NEG.W Rd | 1 | | | | | | |
| | NEG.L ERd | 1 | | | | | | |
| NOP | NOP | 1 | | | | | | |
| NOT | NOT.B Rd | 1 | | | | | | |
| | NOT.W Rd | 1 | | | | | | |
| | NOT.L ERd | 1 | | | | | | |
| OR | OR.B #xx:8,Rd | 1 | | | | | | |
| | OR.B Rs,Rd | 1 | | | | | | |
| | OR.W #xx:16,Rd | 2 | | | | | | |
| | OR.W Rs,Rd | 1 | | | | | | |
| | OR.L #xx:32,ERd | 3 | | | | | | |
| | OR.L ERs,ERd | 2 | | | | | | |
| ORC | ORC #xx:8,CCR | 1 | | | | | | |
| | ORC #xx:8,EXR | 2 | | | | | | |
| POP | POP.W Rn | 1 | | | | 1 | 1 | |
| | POP.L ERn | 2 | | | | 2 | 1 | |
| PUSH | PUSH.W Rn | 1 | | | | 1 | 1 | |
| | PUSH.L ERn | 2 | | | | 2 | 1 | |
| ROTL | ROTL.B Rd | 1 | | | | | | |
| | ROTL.B #2,Rd | 1 | | | | | | |
| | ROTL.W Rd | 1 | | | | | | |
| | ROTL.W #2,Rd | 1 | | | | | | |
| | ROTL.L ERd | 1 | | | | | | |
| | ROTL.L #2,ERd | 1 | | | | | | |

| Instruction | Mnemonic | Instruction Fetch I | Branch | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------|----------------|---------------------------|----------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| | | | Address Read J | | | | |
| ROTR | ROTR.B Rd | 1 | | | | | |
| | ROTR.B #2,Rd | 1 | | | | | |
| | ROTR.W Rd | 1 | | | | | |
| | ROTR.W #2,Rd | 1 | | | | | |
| | ROTR.L ERd | 1 | | | | | |
| | ROTR.L #2,ERd | 1 | | | | | |
| ROTXL | ROTXL.B Rd | 1 | | | | | |
| | ROTXL.B #2,Rd | 1 | | | | | |
| | ROTXL.W Rd | 1 | | | | | |
| | ROTXL.W #2,Rd | 1 | | | | | |
| | ROTXL.L ERd | 1 | | | | | |
| | ROTXL.L #2,ERd | 1 | | | | | |
| ROTXR | ROTXR.B Rd | 1 | | | | | |
| | ROTXR.B #2,Rd | 1 | | | | | |
| | ROTXR.W Rd | 1 | | | | | |
| | ROTXR.W #2,Rd | 1 | | | | | |
| | ROTXR.L ERd | 1 | | | | | |
| | ROTXR.L #2,ERd | 1 | | | | | |
| RTE | RTE | 2 | | 2/3*1 | | | 1 |
| RTS | RTS | Normal | | 1 | | | 1 |
| | | Advanced | 2 | 2 | | | 1 |
| SHAL | SHAL.B Rd | 1 | | | | | |
| | SHAL.B #2,Rd | 1 | | | | | |
| | SHAL.W Rd | 1 | | | | | |
| | SHAL.W #2,Rd | 1 | | | | | |
| | SHAL.L ERd | 1 | | | | | |
| | SHAL.L #2,ERd | 1 | | | | | |
| SHAR | SHAR.B Rd | 1 | | | | | |
| | SHAR.B #2,Rd | 1 | | | | | |
| | SHAR.W Rd | 1 | | | | | |
| | SHAR.W #2,Rd | 1 | | | | | |
| | SHAR.L ERd | 1 | | | | | |
| | SHAR.L #2,ERd | 1 | | | | | |

| Instruction | Mnemonic | Instruction Fetch I | Branch Address Read J | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------------|------------------------|---------------------------|--------------------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| | | | | | | | |
| SHLL | SHLL.B Rd | 1 | | | | | |
| | SHLL.B #2,Rd | 1 | | | | | |
| | SHLL.W Rd | 1 | | | | | |
| | SHLL.W #2,Rd | 1 | | | | | |
| | SHLL.L ERd | 1 | | | | | |
| | SHLL.L #2,ERd | 1 | | | | | |
| SHLR | SHLR.B Rd | 1 | | | | | |
| | SHLR.B #2,Rd | 1 | | | | | |
| | SHLR.W Rd | 1 | | | | | |
| | SHLR.W #2,Rd | 1 | | | | | |
| | SHLR.L ERd | 1 | | | | | |
| | SHLR.L #2,ERd | 1 | | | | | |
| SLEEP | SLEEP | 1 | | | | | 1 |
| STC | STC.B CCR,Rd | 1 | | | | | |
| | STC.B EXR,Rd | 1 | | | | | |
| | STC.W CCR,@ERd | 2 | | | | 1 | |
| | STC.W EXR,@ERd | 2 | | | | 1 | |
| | STC.W CCR,@(d:16,ERd) | 3 | | | | 1 | |
| | STC.W EXR,@(d:16,ERd) | 3 | | | | 1 | |
| | STC.W CCR,@(d:32,ERd) | 5 | | | | 1 | |
| | STC.W EXR,@(d:32,ERd) | 5 | | | | 1 | |
| | STC.W CCR,@-ERd | 2 | | | | 1 | 1 |
| | STC.W EXR,@-ERd | 2 | | | | 1 | 1 |
| | STC.W CCR,@aa:16 | 3 | | | | 1 | |
| | STC.W EXR,@aa:16 | 3 | | | | 1 | |
| | STC.W CCR,@aa:32 | 4 | | | | 1 | |
| STC.W EXR,@aa:32 | 4 | | | | 1 | | |
| STM ^{*4} | STM.L (ERn-ERn+1),@-SP | 2 | | 4 | | | 1 |
| | STM.L (ERn-ERn+2),@-SP | 2 | | 6 | | | 1 |
| | STM.L (ERn-ERn+3),@-SP | 2 | | 8 | | | 1 |
| SUB | SUB.B Rs,Rd | 1 | | | | | |
| | SUB.W #xx:16,Rd | 2 | | | | | |
| | SUB.W Rs,Rd | 1 | | | | | |
| | SUB.L #xx:32,ERd | 3 | | | | | |
| | SUB.L ERs,ERd | 1 | | | | | |

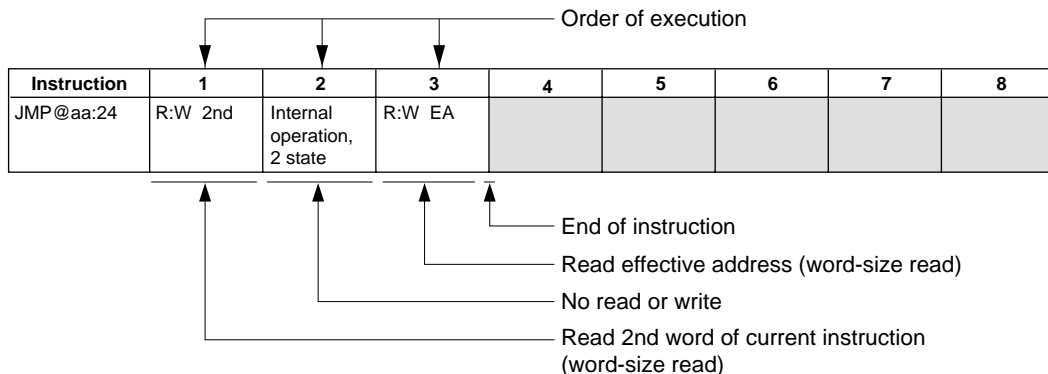
| Instruction | Mnemonic | Instruction Fetch I | Branch | Stack Operation K | Byte Data Access L | Word Data Access M | Internal Operation N |
|-------------|------------------------|---------------------------|----------------------|-------------------------|--------------------------|--------------------------|----------------------------|
| | | | Address Read J | | | | |
| SUBS | SUBS #1/2/4,ERd | 1 | | | | | |
| SUBX | SUBX #xx:8,Rd | 1 | | | | | |
| | SUBX Rs,Rd | 1 | | | | | |
| TAS | TAS @ERd ^{*3} | 2 | | | 2 | | |
| TRAPA | TRAPA #x:2 | Normal | 2 | 1 | 2/3 ^{*1} | | 2 |
| | | Advanced | 2 | 2 | 2/3 ^{*1} | | 2 |
| XOR | XOR.B #xx:8,Rd | 1 | | | | | |
| | XOR.B Rs,Rd | 1 | | | | | |
| | XOR.W #xx:16,Rd | 2 | | | | | |
| | XOR.W Rs,Rd | 1 | | | | | |
| | XOR.L #xx:32,ERd | 3 | | | | | |
| | XOR.L ERs,ERd | 2 | | | | | |
| XORC | XORC #xx:8,CCR | 1 | | | | | |
| | XORC #xx:8,EXR | 2 | | | | | |

- Notes:
1. 2 when EXR is invalid, 3 when valid.
 2. When n bytes of data are transferred.
 3. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
 4. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

A.5 Bus States during Instruction Execution

Table A.6 indicates the types of cycles that occur during instruction execution by the CPU. See table A.4 for the number of states per cycle.

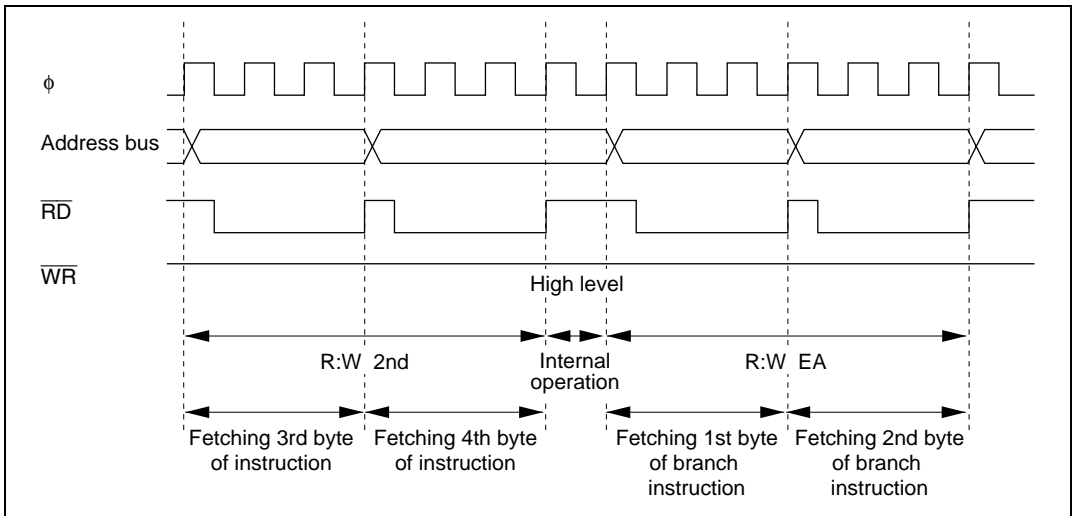
How to Read the Table:



Legend:

| | |
|------|---|
| R:B | Byte-size read |
| R:W | Word-size read |
| W:B | Byte-size write |
| W:W | Word-size write |
| :M | Transfer of the bus is not performed immediately after this cycle |
| 2nd | Address of 2nd word (3rd and 4th bytes) |
| 3rd | Address of 3rd word (5th and 6th bytes) |
| 4th | Address of 4th word (7th and 8th bytes) |
| 5th | Address of 5th word (9th and 10th bytes) |
| NEXT | Start address of instruction following executing instruction |
| EA | Effective address |
| VEC | Vector address |

Figure A.1 shows timing waveforms for the address bus and the \overline{RD} and \overline{WR} signals during execution of the above instruction with an 8-bit bus, using three-state access with no wait states.



**Figure A.1 Address Bus, \overline{RD} and \overline{WR} Timing
(8-Bit Bus, Three-State Access, No Wait States)**

Table A.6 Instruction Execution Cycle

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|-----------------------|----------|----------|---------------|---------------|---------------|---|---|---|---|
| ADD.B #xx:8,Rd | R:W NEXT | | | | | | | | |
| ADD.B Rs,Rd | R:W NEXT | | | | | | | | |
| ADD.W #xx:16,Rd | R:W 2nd | R:W NEXT | | | | | | | |
| ADD.W Rs,Rd | R:W NEXT | | | | | | | | |
| ADD.L #xx:32,ERd | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| ADD.L ERs,ERd | R:W NEXT | | | | | | | | |
| ADDS #1/2/4,ERd | R:W NEXT | | | | | | | | |
| ADDX #xx:8,Rd | R:W NEXT | | | | | | | | |
| ADDX Rs,Rd | R:W NEXT | | | | | | | | |
| AND.B #xx:8,Rd | R:W NEXT | | | | | | | | |
| AND.B Rs,Rd | R:W NEXT | | | | | | | | |
| AND.W #xx:16,Rd | R:W 2nd | R:W NEXT | | | | | | | |
| AND.W Rs,Rd | R:W NEXT | | | | | | | | |
| AND.L #xx:32,ERd | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| AND.L ERs,ERd | R:W 2nd | R:W NEXT | | | | | | | |
| ANDC #xx:8,CCR | R:W NEXT | | | | | | | | |
| ANDC #xx:8,EXR | R:W 2nd | R:W NEXT | | | | | | | |
| BAND #xx:3,Rd | R:W NEXT | | | | | | | | |
| BAND #xx:3,@ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BAND #xx:3,@aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BAND #xx:3, @aa:16 | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BAND #xx:3, @aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BRA d:8 (BT d:8) | R:W NEXT | R:W EA | | | | | | | |
| BRN d:8 (BF d:8) | R:W NEXT | R:W EA | | | | | | | |
| BHI d:8 | R:W NEXT | R:W EA | | | | | | | |
| BLS d:8 | R:W NEXT | R:W EA | | | | | | | |
| BCC d:8 (BHS d:8) | R:W NEXT | R:W EA | | | | | | | |
| BCS d:8 (BLO d:8) | R:W NEXT | R:W EA | | | | | | | |
| BNE d:8 | R:W NEXT | R:W EA | | | | | | | |
| BEQ d:8 | R:W NEXT | R:W EA | | | | | | | |
| BVC d:8 | R:W NEXT | R:W EA | | | | | | | |
| BVS d:8 | R:W NEXT | R:W EA | | | | | | | |
| BPL d:8 | R:W NEXT | R:W EA | | | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|---------------------|----------|-----------------------------|--------|---|---|---|---|---|---|
| BMI d:8 | R:W NEXT | R:W EA | | | | | | | |
| BGE d:8 | R:W NEXT | R:W EA | | | | | | | |
| BLT d:8 | R:W NEXT | R:W EA | | | | | | | |
| BGT d:8 | R:W NEXT | R:W EA | | | | | | | |
| BLE d:8 | R:W NEXT | R:W EA | | | | | | | |
| BRA d:16 (BT d:16) | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BRN d:16 (BF d:16) | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BHI d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BLS d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BCC d:16 (BHS d:16) | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BCS d:16 (BLO d:16) | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BNE d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BEQ d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BVC d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BVS d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BPL d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BMI d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BGE d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|--------------------|----------|-----------------------------|------------|------------|------------|--------|---|---|---|
| BLT d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BGT d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BLE d:16 | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| BCLR #xx:3,Rd | R:W NEXT | | | | | | | | |
| BCLR #xx:3,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BCLR #xx:3,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BCLR #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BCLR #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BCLR Rn,Rd | R:W NEXT | | | | | | | | |
| BCLR Rn,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BCLR Rn,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BCLR Rn,@aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BCLR Rn,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BIAND #xx:3,Rd | R:W NEXT | | | | | | | | |
| BIAND #xx:3,@ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BIAND #xx:3,@aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BIAND #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BIAND #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BILD #xx:3,Rd | R:W NEXT | | | | | | | | |
| BILD #xx:3,@ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BILD #xx:3,@aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BILD #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B: EA | R:W:M NEXT | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|------------------------|----------|----------|---------------|---------------|---------------|--------|---|---|---|
| BILD #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BIOR #xx:3,Rd | R:W NEXT | | | | | | | | |
| BIOR #xx:3,@ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BIOR #xx:3,@aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BIOR #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BIOR #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BIST #xx:3,Rd | R:W NEXT | | | | | | | | |
| BIST #xx:3,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BIST #xx:3,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BIST #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BIST #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BIXOR #xx:3,Rd | R:W NEXT | | | | | | | | |
| BIXOR #xx:3, @ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BIXOR #xx:3, @aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BIXOR #xx:3, @aa:16 | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BIXOR #xx:3, @aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BLD #xx:3,Rd | R:W NEXT | | | | | | | | |
| BLD #xx:3,@ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BLD #xx:3,@aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BLD #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BLD #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BNOT #xx:3,Rd | R:W NEXT | | | | | | | | |
| BNOT #xx:3,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|-----------------------|----------|----------|---------------|---------------|---------------|--------|---|---|---|
| BNOT #xx:3,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BNOT #xx:3, @aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BNOT #xx:3, @aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BNOT Rn,Rd | R:W NEXT | | | | | | | | |
| BNOT Rn,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BNOT Rn,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BNOT Rn,@aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BNOT Rn,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BOR #xx:3,Rd | R:W NEXT | | | | | | | | |
| BOR #xx:3,@ERd | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BOR #xx:3,@aa:8 | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BOR #xx:3,@aa:16 | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BOR #xx:3,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W NEXT | | | | |
| BSET #xx:3,Rd | R:W NEXT | | | | | | | | |
| BSET #xx:3,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BSET #xx:3,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BSET #xx:3, @aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BSET #xx:3, @aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BSET Rn,Rd | R:W NEXT | | | | | | | | |
| BSET Rn,@ERd | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BSET Rn,@aa:8 | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BSET Rn,@aa:16 | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BSET Rn,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |

| Instruction | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|-----------------------|----------|---|-----------------------------------|--------------------|--------------------|------------------|--------|---|---|---|
| BSR d:8 | Advanced | R:W NEXT | R:W EA | W:W:M Stack (H) | W:W Stack (L) | | | | | |
| BSR d:16 | Advanced | R:W 2nd | Internal operation, 1 state | R:W EA | W:W:M Stack (H) | W:W Stack (L) | | | | |
| BST #xx:3,Rd | | R:W NEXT | | | | | | | | |
| BST #xx:3,@ERd | | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BST #xx:3,@aa:8 | | R:W 2nd | R:B:M EA | R:W:M NEXT | W:B EA | | | | | |
| BST #xx:3,@aa:16 | | R:W 2nd | R:W 3rd | R:B:M EA | R:W:M NEXT | W:B EA | | | | |
| BST #xx:3,@aa:32 | | R:W 2nd | R:W 3rd | R:W 4th | R:B:M EA | R:W:M NEXT | W:B EA | | | |
| BTST #xx:3,Rd | | R:W NEXT | | | | | | | | |
| BTST #xx:3,@ERd | | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BTST #xx:3,@aa:8 | | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BTST #xx:3, @aa:16 | | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BTST #xx:3, @aa:32 | | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BTST Rn,Rd | | R:W NEXT | | | | | | | | |
| BTST Rn,@ERd | | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BTST Rn,@aa:8 | | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BTST Rn,@aa:16 | | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BTST Rn,@aa:32 | | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| BXOR #xx:3,Rd | | R:W NEXT | | | | | | | | |
| BXOR #xx:3,@ERd | | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BXOR #xx:3,@aa:8 | | R:W 2nd | R:B EA | R:W:M NEXT | | | | | | |
| BXOR #xx:3, @aa:16 | | R:W 2nd | R:W 3rd | R:B EA | R:W:M NEXT | | | | | |
| BXOR #xx:3, @aa:32 | | R:W 2nd | R:W 3rd | R:W 4th | R:B EA | R:W:M NEXT | | | | |
| CLRMAC | | Cannot be used in the H8S/2138 Group and H8S/2134 Group | | | | | | | | |

| Instruction | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|------------------|----------|----------|-------------------------------|-------------------------------|------------------------------------|-----------------------|----------|---|---|---|
| CMP.B #xx:8,Rd | | R:W NEXT | | | | | | | | |
| CMP.B Rs,Rd | | R:W NEXT | | | | | | | | |
| CMP.W #xx:16,Rd | | R:W 2nd | R:W NEXT | | | | | | | |
| CMP.W Rs,Rd | | R:W NEXT | | | | | | | | |
| CMP.L #xx:32,ERd | | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| CMP.L ERs,ERd | | R:W NEXT | | | | | | | | |
| DAA Rd | | R:W NEXT | | | | | | | | |
| DAS Rd | | R:W NEXT | | | | | | | | |
| DEC.B Rd | | R:W NEXT | | | | | | | | |
| DEC.W #1/2,Rd | | R:W NEXT | | | | | | | | |
| DEC.L #1/2,ERd | | R:W NEXT | | | | | | | | |
| DIVXS.B Rs,Rd | | R:W 2nd | R:W NEXT | Internal operation, 11 states | | | | | | |
| DIVXS.W Rs,ERd | | R:W 2nd | R:W NEXT | Internal operation, 19 states | | | | | | |
| DIVXU.B Rs,Rd | | R:W NEXT | Internal operation, 11 states | | | | | | | |
| DIVXU.W Rs,ERd | | R:W NEXT | Internal operation, 19 states | | | | | | | |
| EEMOV.B | | R:W 2nd | R:B EAs ^{*1} | R:B EAd ^{*1} | R:B EAs ^{*2} | W:B EAd ^{*2} | R:W NEXT | | | |
| EEMOV.W | | R:W 2nd | R:B EAs ^{*1} | R:B EAd ^{*1} | R:B EAs ^{*2} | W:B EAd ^{*2} | R:W NEXT | | | |
| EXTS.W Rd | | R:W NEXT | | | ← Repeated n times ^{*2} → | | | | | |
| EXTS.L ERd | | R:W NEXT | | | | | | | | |
| EXTU.W Rd | | R:W NEXT | | | | | | | | |
| EXTU.L ERd | | R:W NEXT | | | | | | | | |
| INC.B Rd | | R:W NEXT | | | | | | | | |
| INC.W #1/2,Rd | | R:W NEXT | | | | | | | | |
| INC.L #1/2,ERd | | R:W NEXT | | | | | | | | |
| JMP @ERn | | R:W NEXT | R:W EA | | | | | | | |
| JMP @aa:24 | | R:W 2nd | Internal operation, 1 state | R:W EA | | | | | | |
| JMP @aa:8 | Advanced | R:W NEXT | R:W:M aa:8 | R:W aa:8 | Internal operation, 1 state | R:W EA | | | | |
| JSR @ERn | Advanced | R:W NEXT | R:W EA | W:W:M Stack (H) | W:W Stack (L) | | | | | |
| JSR @aa:24 | Advanced | R:W 2nd | Internal operation, 1 state | R:W EA | W:W:M Stack (H) | W:W Stack (L) | | | | |
| JSR @aa:8 | Advanced | R:W NEXT | R:W:M aa:8 | R:W aa:8 | W:W:M Stack (H) | W:W Stack (L) | R:W EA | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|------------------------------|---|---------------|-----------------------------------|--------------------------|------------------------|--------|---|---|---|
| LDC #xx:8,CCR | R:W NEXT | | | | | | | | |
| LDC #xx:8,EXR | R:W 2nd | R:W NEXT | | | | | | | |
| LDC Rs,CCR | R:W NEXT | | | | | | | | |
| LDC Rs,EXR | R:W NEXT | | | | | | | | |
| LDC @ERs,CCR | R:W 2nd | R:W NEXT | R:W EA | | | | | | |
| LDC @ERs,EXR | R:W 2nd | R:W NEXT | R:W EA | | | | | | |
| LDC @(d:16,ERs), CCR | R:W 2nd | R:W 3rd | R:W NEXT | R:W EA | | | | | |
| LDC @(d:16,ERs), EXR | R:W 2nd | R:W 3rd | R:W NEXT | R:W EA | | | | | |
| LDC @(d:32,ERs), CCR | R:W 2nd | R:W 3rd | R:W 4th | R:W 5th | R:W NEXT | R:W EA | | | |
| LDC @(d:32,ERs), EXR | R:W 2nd | R:W 3rd | R:W 4th | R:W 5th | R:W NEXT | R:W EA | | | |
| LDC @ERs+,CCR | R:W 2nd | R:W NEXT | Internal operation, 1 state | R:W EA | | | | | |
| LDC @ERs+,EXR | R:W 2nd | R:W NEXT | Internal operation, 1 state | R:W EA | | | | | |
| LDC @aa:16,CCR | R:W 2nd | R:W 3rd | R:W NEXT | R:W EA | | | | | |
| LDC @aa:16,EXR | R:W 2nd | R:W 3rd | R:W NEXT | R:W EA | | | | | |
| LDC @aa:32,CCR | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | R:W EA | | | | |
| LDC @aa:32,EXR | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | R:W EA | | | | |
| LDM.L @SP+, (ERn-ERn+1)*9 | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | R:W:M Stack (H) *3 | R:W Stack (L) *3 | | | | |
| LDM.L @SP+, (ERn-ERn+2)*9 | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | R:W:M Stack (H) *3 | R:W Stack (L) *3 | | | | |
| LDM.L @SP+, (ERn-ERn+3)*9 | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | R:W:M Stack (H) *3 | R:W Stack (L) *3 | | | | |
| LDMAC ERs,MACH | Cannot be used in the H8S/2138 Group and H8S/2134 Group | | | | | | | | |
| LDMAC ERs,MACL | | | | | | | | | |
| MAC @ERn+, @ERm+ | | | | | | | | | |
| MOV.B #xx:8,Rd | R:W NEXT | | | | | | | | |
| MOV.B Rs,Rd | R:W NEXT | | | | | | | | |
| MOV.B @ERs,Rd | R:W NEXT | R:B EA | | | | | | | |
| MOV.B @(d:16,ERs), Rd | R:W 2nd | R:W NEXT | R:B EA | | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|--------------------------|----------|-----------------------------------|----------|----------|--------|---|---|---|---|
| MOV.B @(d:32,ERs),Rd | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | R:B EA | | | | |
| MOV.B @ERs+,Rd | R:W NEXT | Internal operation, 1 state | R:B EA | | | | | | |
| MOV.B @aa:8,Rd | R:W NEXT | R:B EA | | | | | | | |
| MOV.B @aa:16,Rd | R:W 2nd | R:W NEXT | R:B EA | | | | | | |
| MOV.B @aa:32,Rd | R:W 2nd | R:W 3rd | R:W NEXT | R:B EA | | | | | |
| MOV.B Rs,@ERd | R:W NEXT | W:B EA | | | | | | | |
| MOV.B Rs, @(d:16,ERd) | R:W 2nd | R:W NEXT | W:B EA | | | | | | |
| MOV.B Rs, @(d:32,ERd) | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | W:B EA | | | | |
| MOV.B Rs,@-ERd | R:W NEXT | Internal operation, 1 state | W:B EA | | | | | | |
| MOV.B Rs,@aa:8 | R:W NEXT | W:B EA | | | | | | | |
| MOV.B Rs,@aa:16 | R:W 2nd | R:W NEXT | W:B EA | | | | | | |
| MOV.B Rs,@aa:32 | R:W 2nd | R:W 3rd | R:W NEXT | W:B EA | | | | | |
| MOV.W #xx:16,Rd | R:W 2nd | R:W NEXT | | | | | | | |
| MOV.W Rs,Rd | R:W NEXT | | | | | | | | |
| MOV.W @ERs,Rd | R:W NEXT | R:W EA | | | | | | | |
| MOV.W @(d:16,ERs),Rd | R:W 2nd | R:W NEXT | R:W EA | | | | | | |
| MOV.W @(d:32,ERs),Rd | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | R:W EA | | | | |
| MOV.W @ERs+,Rd | R:W NEXT | Internal operation, 1 state | R:W EA | | | | | | |
| MOV.W @aa:16,Rd | R:W 2nd | R:W NEXT | R:W EA | | | | | | |
| MOV.W @aa:32,Rd | R:W 2nd | R:W 3rd | R:W NEXT | R:B EA | | | | | |
| MOV.W Rs,@ERd | R:W NEXT | W:W EA | | | | | | | |
| MOV.W Rs, @(d:16,ERd) | R:W 2nd | R:W NEXT | W:W EA | | | | | | |
| MOV.W Rs, @(d:32,ERd) | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | W:W EA | | | | |
| MOV.W Rs,@-ERd | R:W NEXT | Internal operation, 1 state | W:W EA | | | | | | |
| MOV.W Rs,@aa:16 | R:W 2nd | R:W NEXT | W:W EA | | | | | | |
| MOV.W Rs,@aa:32 | R:W 2nd | R:W 3rd | R:W NEXT | W:W EA | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|-----------------------|---|-------------------------------|-------------------------------|----------|----------|----------|----------|---|---|
| MOV.L #xx:32,ERd | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| MOV.L ERs,ERd | R:W NEXT | | | | | | | | |
| MOV.L @ERs,ERd | R:W 2nd | R:W:M NEXT | R:W:M EA | R:W EA+2 | | | | | |
| MOV.L @(d:16,ERs),ERd | R:W 2nd | R:W:M 3rd | R:W NEXT | R:W:M EA | R:W EA+2 | | | | |
| MOV.L @(d:32,ERs),ERd | R:W 2nd | R:W:M 3rd | R:W:M 4th | R:W 5th | R:W NEXT | R:W:M EA | R:W EA+2 | | |
| MOV.L @ERs+,ERd | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | R:W:M EA | R:W EA+2 | | | | |
| MOV.L @aa:16,ERd | R:W 2nd | R:W:M 3rd | R:W NEXT | R:W:M EA | R:W EA+2 | | | | |
| MOV.L @aa:32,ERd | R:W 2nd | R:W:M 3rd | R:W 4th | R:W NEXT | R:W:M EA | R:W EA+2 | | | |
| MOV.L ERs,@ERd | R:W 2nd | R:W:M NEXT | W:W:M EA | W:W EA+2 | | | | | |
| MOV.L ERs,@(d:16,ERd) | R:W 2nd | R:W:M 3rd | R:W NEXT | W:W:M EA | W:W EA+2 | | | | |
| MOV.L ERs,@(d:32,ERd) | R:W 2nd | R:W:M 3rd | R:W:M 4th | R:W 5th | R:W NEXT | W:W:M EA | W:W EA+2 | | |
| MOV.L ERs,@-ERd | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | W:W:M EA | W:W EA+2 | | | | |
| MOV.L ERs,@aa:16 | R:W 2nd | R:W:M 3rd | R:W NEXT | W:W:M EA | W:W EA+2 | | | | |
| MOV.L ERs,@aa:32 | R:W 2nd | R:W:M 3rd | R:W 4th | R:W NEXT | W:W:M EA | W:W EA+2 | | | |
| MOVFPPE @aa:16,Rd | Cannot be used in the H8S/2138 Group and H8S/2134 Group | | | | | | | | |
| MOVTPE Rs,@aa:16 | | | | | | | | | |
| MULXS.B Rs,Rd | R:W 2nd | R:W NEXT | Internal operation, 11 states | | | | | | |
| MULXS.W Rs,ERd | R:W 2nd | R:W NEXT | Internal operation, 19 states | | | | | | |
| MULXU.B Rs,Rd | R:W NEXT | Internal operation, 11 states | | | | | | | |
| MULXU.W Rs,ERd | R:W NEXT | Internal operation, 19 states | | | | | | | |
| NEG.B Rd | R:W NEXT | | | | | | | | |
| NEG.W Rd | R:W NEXT | | | | | | | | |
| NEG.L ERd | R:W NEXT | | | | | | | | |
| NOP | R:W NEXT | | | | | | | | |
| NOT.B Rd | R:W NEXT | | | | | | | | |
| NOT.W Rd | R:W NEXT | | | | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|-----------------|----------|-----------------------------|-----------------------------|----------|----------|---|---|---|---|
| NOT.L ERd | R:W NEXT | | | | | | | | |
| OR.B #xx:8,Rd | R:W NEXT | | | | | | | | |
| OR.B Rs,Rd | R:W NEXT | | | | | | | | |
| OR.W #xx:16,Rd | R:W 2nd | R:W NEXT | | | | | | | |
| OR.W Rs,Rd | R:W NEXT | | | | | | | | |
| OR.L #xx:32,ERd | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| OR.L ERs,ERd | R:W 2nd | R:W NEXT | | | | | | | |
| ORC #xx:8,CCR | R:W NEXT | | | | | | | | |
| ORC #xx:8,EXR | R:W 2nd | R:W NEXT | | | | | | | |
| POP.W Rn | R:W NEXT | Internal operation, 1 state | R:W EA | | | | | | |
| POP.L ERn | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | R:W:M EA | R:W EA+2 | | | | |
| PUSH.W Rn | R:W NEXT | Internal operation, 1 state | W:W EA | | | | | | |
| PUSH.L ERn | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | W:W:M EA | W:W EA+2 | | | | |
| ROTL.B Rd | R:W NEXT | | | | | | | | |
| ROTL.B #2,Rd | R:W NEXT | | | | | | | | |
| ROTL.W Rd | R:W NEXT | | | | | | | | |
| ROTL.W #2,Rd | R:W NEXT | | | | | | | | |
| ROTL.L ERd | R:W NEXT | | | | | | | | |
| ROTL.L #2,ERd | R:W NEXT | | | | | | | | |
| ROTR.B Rd | R:W NEXT | | | | | | | | |
| ROTR.B #2,Rd | R:W NEXT | | | | | | | | |
| ROTR.W Rd | R:W NEXT | | | | | | | | |
| ROTR.W #2,Rd | R:W NEXT | | | | | | | | |
| ROTR.L ERd | R:W NEXT | | | | | | | | |
| ROTR.L #2,ERd | R:W NEXT | | | | | | | | |
| ROTXL.B Rd | R:W NEXT | | | | | | | | |
| ROTXL.B #2,Rd | R:W NEXT | | | | | | | | |
| ROTXL.W Rd | R:W NEXT | | | | | | | | |
| ROTXL.W #2,Rd | R:W NEXT | | | | | | | | |
| ROTXL.L ERd | R:W NEXT | | | | | | | | |

| Instruction | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|----------------|----------|----------|-----------------|---------------|-----------------------------|-----------------------------|-------------------|---|---|---|
| ROTXL.L #2,ERd | | R:W NEXT | | | | | | | | |
| ROTXR.B Rd | | R:W NEXT | | | | | | | | |
| ROTXR.B #2,Rd | | R:W NEXT | | | | | | | | |
| ROTXR.W Rd | | R:W NEXT | | | | | | | | |
| ROTXR.W #2,Rd | | R:W NEXT | | | | | | | | |
| ROTXR.L ERd | | R:W NEXT | | | | | | | | |
| ROTXR.L #2,ERd | | R:W NEXT | | | | | | | | |
| RTE | | R:W NEXT | R:W Stack (EXR) | R:W Stack (H) | R:W Stack (L) | Internal operation, 1 state | R:W ^{*4} | | | |
| RTS | Advanced | R:W NEXT | R:W:M Stack (H) | R:W Stack (L) | Internal operation, 1 state | R:W ^{*4} | | | | |
| SHAL.B Rd | | R:W NEXT | | | | | | | | |
| SHAL.B #2,Rd | | R:W NEXT | | | | | | | | |
| SHAL.W Rd | | R:W NEXT | | | | | | | | |
| SHAL.W #2,Rd | | R:W NEXT | | | | | | | | |
| SHAL.L ERd | | R:W NEXT | | | | | | | | |
| SHAL.L #2,ERd | | R:W NEXT | | | | | | | | |
| SHAR.B Rd | | R:W NEXT | | | | | | | | |
| SHAR.B #2,Rd | | R:W NEXT | | | | | | | | |
| SHAR.W Rd | | R:W NEXT | | | | | | | | |
| SHAR.W #2,Rd | | R:W NEXT | | | | | | | | |
| SHAR.L ERd | | R:W NEXT | | | | | | | | |
| SHAR.L #2,ERd | | R:W NEXT | | | | | | | | |
| SHLL.B Rd | | R:W NEXT | | | | | | | | |
| SHLL.B #2,Rd | | R:W NEXT | | | | | | | | |
| SHLL.W Rd | | R:W NEXT | | | | | | | | |
| SHLL.W #2,Rd | | R:W NEXT | | | | | | | | |
| SHLL.L ERd | | R:W NEXT | | | | | | | | |
| SHLL.L #2,ERd | | R:W NEXT | | | | | | | | |
| SHLR.B Rd | | R:W NEXT | | | | | | | | |
| SHLR.B #2,Rd | | R:W NEXT | | | | | | | | |
| SHLR.W Rd | | R:W NEXT | | | | | | | | |
| SHLR.W #2,Rd | | R:W NEXT | | | | | | | | |
| SHLR.L ERd | | R:W NEXT | | | | | | | | |
| SHLR.L #2,ERd | | R:W NEXT | | | | | | | | |

| Instruction | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|---------------------------|---|-----------------------|-----------------------------|--------------------|------------------|--------|---|---|---|
| SLEEP | R:W NEXT | Internal operation :M | | | | | | | |
| STC CCR,Rd | R:W NEXT | | | | | | | | |
| STC EXR,Rd | R:W NEXT | | | | | | | | |
| STC CCR,@ERd | R:W 2nd | R:W NEXT | W:W EA | | | | | | |
| STC EXR,@ERd | R:W 2nd | R:W NEXT | W:W EA | | | | | | |
| STC CCR,@(d:16,ERd) | R:W 2nd | R:W 3rd | R:W NEXT | W:W EA | | | | | |
| STC EXR,@(d:16,ERd) | R:W 2nd | R:W 3rd | R:W NEXT | W:W EA | | | | | |
| STC CCR,@(d:32,ERd) | R:W 2nd | R:W 3rd | R:W 4th | R:W 5th | R:W NEXT | W:W EA | | | |
| STC EXR,@(d:32,ERd) | R:W 2nd | R:W 3rd | R:W 4th | R:W 5th | R:W NEXT | W:W EA | | | |
| STC CCR,@-ERd | R:W 2nd | R:W NEXT | Internal operation, 1 state | W:W EA | | | | | |
| STC EXR,@-ERd | R:W 2nd | R:W NEXT | Internal operation, 1 state | W:W EA | | | | | |
| STC CCR,@aa:16 | R:W 2nd | R:W 3rd | R:W NEXT | W:W EA | | | | | |
| STC EXR,@aa:16 | R:W 2nd | R:W 3rd | R:W NEXT | W:W EA | | | | | |
| STC CCR,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | W:W EA | | | | |
| STC EXR,@aa:32 | R:W 2nd | R:W 3rd | R:W 4th | R:W NEXT | W:W EA | | | | |
| STM.L (ERn-ERn+1), @-SP*9 | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | W:W:M Stack (H) *3 | W:W Stack (L) *3 | | | | |
| STM.L (ERn-ERn+2), @-SP*9 | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | W:W:M Stack (H) *3 | W:W Stack (L) *3 | | | | |
| STM.L (ERn-ERn+3), @-SP*9 | R:W 2nd | R:W:M NEXT | Internal operation, 1 state | W:W:M Stack (H) *3 | W:W Stack (L) *3 | | | | |
| STMACH,ERd | Cannot be used in the H8S/2138 Group and H8S/2134 Group | | | | | | | | |
| STMACL,ERd | | | | | | | | | |
| SUB.B Rs,Rd | R:W NEXT | | | | | | | | |
| SUB.W #xx:16,Rd | R:W 2nd | R:W NEXT | | | | | | | |
| SUB.W Rs,Rd | R:W NEXT | | | | | | | | |
| SUB.L #xx:32,ERd | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| SUB.L ERs,ERd | R:W NEXT | | | | | | | | |

| Instruction | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|------------------------------|----------|-------------------|-----------------------------|-----------------------------|-------------------|-----------------|-----------|-----------|-----------------------------|-------------------|
| SUBS #1/2/4,ERd | | R:W NEXT | | | | | | | | |
| SUBX #xx:8,Rd | | R:W NEXT | | | | | | | | |
| SUBX Rs,Rd | | R:W NEXT | | | | | | | | |
| TAS @ERd ^{*5} | | R:W 2nd | R:W NEXT | R:B:M EA | W:B EA | | | | | |
| TRAPA #x:2 | Advanced | R:W NEXT | Internal operation, 1 state | W:W Stack (L) | W:W Stack (H) | W:W Stack (EXR) | R:W:M VEC | R:W VEC+2 | Internal operation, 1 state | R:W ^{**} |
| XOR.B #xx8,Rd | | R:W NEXT | | | | | | | | |
| XOR.B Rs,Rd | | R:W NEXT | | | | | | | | |
| XOR.W #xx:16,Rd | | R:W 2nd | R:W NEXT | | | | | | | |
| XOR.W Rs,Rd | | R:W NEXT | | | | | | | | |
| XOR.L #xx:32,ERd | | R:W 2nd | R:W 3rd | R:W NEXT | | | | | | |
| XOR.L ERs,ERd | | R:W 2nd | R:W NEXT | | | | | | | |
| XORC #xx:8,CCR | | R:W NEXT | | | | | | | | |
| XORC #xx:8,EXR | | R:W 2nd | R:W NEXT | | | | | | | |
| Reset exception handling | Advanced | R:W:M VEC | R:W VEC+2 | Internal operation, 1 state | R:W ^{*6} | | | | | |
| Interrupt exception handling | Advanced | R:W ^{*7} | Internal operation, 1 state | W:W Stack (L) | W:W Stack (H) | W:W Stack (EXR) | R:W:M VEC | R:W VEC+2 | Internal operation, 1 state | R:W ^{**} |

- Notes:
1. EAs is the contents of ER5. EAd is the contents of ER6.
 2. EAs is the contents of ER5. EAd is the contents of ER6. Both registers are incremented by 1 after execution of the instruction. n is the initial value of R4L or R4. If n = 0, these bus cycles are not executed.
 3. Repeated two times to save or restore two registers, three times for three registers, or four times for four registers.
 4. Start address after return.
 5. Only register ER0, ER1, ER4, or ER5 should be used when using the TAS instruction.
 6. Start address of the program.
 7. Prefetch address, equal to two plus the PC value pushed onto the stack. In recovery from sleep mode or software standby mode the read operation is replaced by an internal operation.
 8. Start address of the interrupt-handling routine.
 9. Only registers ER0 to ER6 should be used when using the STM/LDM instruction.

Appendix B Internal I/O Registers

B.1 Addresses

| Address | Register Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module Name | Bus Width |
|------------------------|---------------|---------|---------|---------|---------|---------|---------|---------|---------|---------------------------|-----------|
| H'EC00 to H'FFFF | MRA | SM1 | SM0 | DM1 | DM0 | MD1 | MD0 | DTS | Sz | DTC | 16/32* |
| | SAR | | | | | | | | | | |
| | MRB | CHNE | DISEL | — | — | — | — | — | — | | |
| | DAR | | | | | | | | | | |
| | CRA | | | | | | | | | | |
| | CRB | | | | | | | | | | |
| H'FEE4 | KBCOMP | IrE | IrCKS2 | IrCKS1 | IrCKS0 | KBADE | KBCH2 | KBCH1 | KBCH0 | IrDA/ expansion A/D | 8 |
| H'FEE6 | DDCSWR | SWE | SW | IE | IF | CLR3 | CLR2 | CLR1 | CLR0 | IIC0 | 8 |
| H'FEE8 | ICRA | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 | Interrupt controller | 8 |
| H'FEE9 | ICRB | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 | | |
| H'FEEA | ICRC | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 | | |
| H'FEEB | ISR | IRQ7F | IRQ6F | IRQ5F | IRQ4F | IRQ3F | IRQ2F | IRQ1F | IRQ0F | | |
| H'FEEC | ISCRH | IRQ7SCB | IRQ7SCA | IRQ6SCB | IRQ6SCA | IRQ5SCB | IRQ5SCA | IRQ4SCB | IRQ4SCA | | |
| H'FEED | ISURL | IRQ3SCB | IRQ3SCA | IRQ2SCB | IRQ2SCA | IRQ1SCB | IRQ1SCA | IRQ0SCB | IRQ0SCA | | |
| H'FEEE | DTCERA | DTCEA7 | DTCEA6 | DTCEA5 | DTCEA4 | DTCEA3 | DTCEA2 | DTCEA1 | DTCEA0 | DTC | 8 |
| H'FEEF | DTCERB | DTCEB7 | DTCEB6 | DTCEB5 | DTCEB4 | DTCEB3 | DTCEB2 | DTCEB1 | DTCEB0 | | |
| H'FEF0 | DTCERC | DTCEC7 | DTCEC6 | DTCEC5 | DTCEC4 | DTCEC3 | DTCEC2 | DTCEC1 | DTCEC0 | | |
| H'FEF1 | DTCERD | DTCED7 | DTCED6 | DTCED5 | DTCED4 | DTCED3 | DTCED2 | DTCED1 | DTCED0 | | |
| H'FEF2 | DTCERE | DTCEE7 | DTCEE6 | DTCEE5 | DTCEE4 | DTCEE3 | DTCEE2 | DTCEE1 | DTCEE0 | | |
| H'FEF3 | DTVECR | SWDTE | DTVEC6 | DTVEC5 | DTVEC4 | DTVEC3 | DTVEC2 | DTVEC1 | DTVEC0 | | |
| H'FEF4 | ABRKCR | CMF | — | — | — | — | — | — | BIE | Interrupt controller | 8 |
| H'FEF5 | BARA | A23 | A22 | A21 | A20 | A19 | A18 | A17 | A16 | | |
| H'FEF6 | BARB | A15 | A14 | A13 | A12 | A11 | A10 | A9 | A8 | | |
| H'FEF7 | BARC | A7 | A6 | A5 | A4 | A3 | A2 | A1 | — | | |
| H'FF80 | FLMCR1 | FWE | SWE | — | — | EV | PV | E | P | FLASH | 8 |
| H'FF81 | FLMCR2 | FLER | — | — | — | — | — | ESU | PSU | | |

| Address | Register | | | | | | | | | Module Name | Bus Width |
|---------|----------|--------------|--------|--------|--------------|--------|--------|-------|-------|-------------|-----------|
| | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| H'FF82 | PCSR | — | — | — | — | — | PWCKB | PWCKA | — | PWM | 8 |
| | EBR1 | — | — | — | — | — | — | EB9/— | EB8/— | FLASH | 8 |
| H'FF83 | SYSCR2 | KWUL1 | KWUL0 | P6PUE | — | SDE | CS4E | CS3E | HI12E | HIF | 8 |
| | EBR2 | EB7 | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 | FLASH | 8 |
| H'FF84 | SBYCR | SSBY | STS2 | STS1 | STS0 | — | SCK2 | SCK1 | SCK0 | SYSTEM | 8 |
| H'FF85 | LPWRCR | DTON | LSON | NESEL | EXCLE | — | — | — | — | | |
| H'FF86 | MSTPCRH | MSTP15 | MSTP14 | MSTP13 | MSTP12 | MSTP11 | MSTP10 | MSTP9 | MSTP8 | | |
| H'FF87 | MSTPCRL | MSTP7 | MSTP6 | MSTP5 | MSTP4 | MSTP3 | MSTP2 | MSTP1 | MSTP0 | | |
| H'FF88 | SMR1 | C/ \bar{A} | CHR | PE | O/ \bar{E} | STOP | MP | CKS1 | CKS0 | SCI1 | 8 |
| | ICCR1 | ICE | IEIC | MST | TRS | ACKE | BBSY | IRIC | SCP | IIC1 | |
| H'FF89 | BRR1 | | | | | | | | | SCI1 | 8 |
| | ICSR1 | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | IIC1 | |
| H'FF8A | SCR1 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | SCI1 | 8 |
| H'FF8B | TDR1 | | | | | | | | | | |
| H'FF8C | SSR1 | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT | | |
| H'FF8D | RDR1 | | | | | | | | | | |
| H'FF8E | SCMR1 | — | — | — | — | SDIR | SINV | — | SMIF | | |
| | ICDR1 | ICDR7 | ICDR6 | ICDR5 | ICDR4 | ICDR3 | ICDR2 | ICDR1 | ICDR0 | IIC1 | 8 |
| | SARX1 | SVAX6 | SVAX5 | SVAX4 | SVAX3 | SVAX2 | SVAX1 | SVAX0 | FSX | | |
| H'FF8F | ICMR1 | MLS | WAIT | CKS2 | CKS1 | CKS0 | BC2 | BC1 | BC0 | | |
| | SAR1 | SVA6 | SVA5 | SVA4 | SVA3 | SVA2 | SVA1 | SVA0 | FS | | |
| H'FF90 | TIER | ICIAE | ICIBE | ICICE | ICIDE | OCIAE | OCIBE | OVIE | — | FRT | 16 |
| H'FF91 | TCSR | ICFA | ICFB | ICFC | ICFD | OCFA | OCFB | OVF | CCLRA | | |
| H'FF92 | FRCH | | | | | | | | | | |
| H'FF93 | FRCL | | | | | | | | | | |
| H'FF94 | OCRAH | | | | | | | | | | |
| | OCRBH | | | | | | | | | | |
| H'FF95 | OCRAL | | | | | | | | | | |
| | OCRBL | | | | | | | | | | |
| H'FF96 | TCR | IEDGA | IEDGB | IEDGC | IEDGD | BUFEA | BUFEB | CKS1 | CKS0 | | |
| H'FF97 | TOCR | ICRDMS | OCRAMS | ICRS | OCRS | OEA | OEB | OLVLA | OLVLB | | |
| H'FF98 | ICRAH | | | | | | | | | | |
| | OCRARH | | | | | | | | | | |
| H'FF99 | ICRAL | | | | | | | | | | |
| | OCRARL | | | | | | | | | | |
| H'FF9A | ICRBH | | | | | | | | | | |
| | OCRAFH | | | | | | | | | | |

Appendix B Internal I/O Registers

| Address | Register | | | | | | | | | Module Name | Bus Width |
|---------|------------------|--------------|----------------|--------|--------------|------------------|--------|--------|--------|-------------|-----------|
| | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| H'FF9B | ICRBL | | | | | | | | | FRT | 16 |
| | OCRAFL | | | | | | | | | | |
| H'FF9C | ICRCH | | | | | | | | | | |
| | OCRDMH | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| H'FF9D | ICRCL | | | | | | | | | | |
| | OCRDML | | | | | | | | | | |
| H'FF9E | ICRDH | | | | | | | | | | |
| H'FF9F | ICRDL | | | | | | | | | | |
| H'FFA0 | SMR2 | C/ \bar{A} | CHR | PE | O/ \bar{E} | STOP | MP | CKS1 | CKS0 | SCI2 | 8 |
| | DADRAH | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | PWMX | |
| | DACR | TEST | PWME | — | — | OEB | OEA | OS | CKS | | |
| H'FFA1 | BRR2 | | | | | | | | | SCI2 | 8 |
| | DADRAL | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | — | PWMX | |
| H'FFA2 | SCR2 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | SCI2 | 8 |
| H'FFA3 | TDR2 | | | | | | | | | | |
| H'FFA4 | SSR2 | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT | | |
| H'FFA5 | RDR2 | | | | | | | | | | |
| H'FFA6 | SCMR2 | — | — | — | — | SDIR | SINV | — | SMIF | | |
| | DADRBH | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | PWMX | 8 |
| | DACNTH | | | | | | | | | | |
| H'FFA7 | DADRBL | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | REGS | | |
| | DACNTL | | | | | | | — | REGS | | |
| H'FFA8 | TCSR0 | OVF | WT/ \bar{IT} | TME | RSTS | RST/ \bar{NMI} | CKS2 | CKS1 | CKS0 | WDT0 | 16 |
| | TCNT0 (write) | | | | | | | | | | |
| H'FFA9 | TCNT0 (read) | | | | | | | | | | |
| H'FFAC | P1PCR | P17PCR | P16PCR | P15PCR | P14PCR | P13PCR | P12PCR | P11PCR | P10PCR | Ports | 8 |
| H'FFAD | P2PCR | P27PCR | P26PCR | P25PCR | P24PCR | P23PCR | P22PCR | P21PCR | P20PCR | | |
| H'FFAE | P3PCR | P37PCR | P36PCR | P35PCR | P34PCR | P33PCR | P32PCR | P31PCR | P30PCR | | |
| H'FFB0 | P1DDR | P17DDR | P16DDR | P15DDR | P14DDR | P13DDR | P12DDR | P11DDR | P10DDR | | |
| H'FFB1 | P2DDR | P27DDR | P26DDR | P25DDR | P24DDR | P23DDR | P22DDR | P21DDR | P20DDR | | |
| H'FFB2 | P1DR | P17DR | P16DR | P15DR | P14DR | P13DR | P12DR | P11DR | P10DR | | |
| H'FFB3 | P2DR | P27DR | P26DR | P25DR | P24DR | P23DR | P22DR | P21DR | P20DR | | |
| H'FFB4 | P3DDR | P37DDR | P36DDR | P35DDR | P34DDR | P33DDR | P32DDR | P31DDR | P30DDR | | |
| H'FFB5 | P4DDR | P47DDR | P46DDR | P45DDR | P44DDR | P43DDR | P42DDR | P41DDR | P40DDR | | |
| H'FFB6 | P3DR | P37DR | P36DR | P35DR | P34DR | P33DR | P32DR | P31DR | P30DR | | |
| H'FFB7 | P4DR | P47DR | P46DR | P45DR | P44DR | P43DR | P42DR | P41DR | P40DR | | |

| Address | Register Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module Name | Bus Width |
|---------|-----------------------|--------------|--------|--------|--------------|--------|--------|--------|--------|----------------------|-----------|
| H'FFB8 | P5DDR | — | — | — | — | — | P52DDR | P51DDR | P50DDR | Ports | 8 |
| H'FFB9 | P6DDR | P67DDR | P66DDR | P65DDR | P64DDR | P63DDR | P62DDR | P61DDR | P60DDR | | |
| H'FFBA | P5DR | — | — | — | — | — | P52DR | P51DR | P50DR | | |
| H'FFBB | P6DR | P67DR | P66DR | P65DR | P64DR | P63DR | P62DR | P61DR | P60DR | | |
| H'FFBD | P8DDR | — | P86DDR | P85DDR | P84DDR | P83DDR | P82DDR | P81DDR | P80DDR | | |
| H'FFBE | P7PIN | P77PIN | P76PIN | P75PIN | P74PIN | P73PIN | P72PIN | P71PIN | P70PIN | | |
| H'FFBF | P8DR | — | P86DR | P85DR | P84DR | P83DR | P82DR | P81DR | P80DR | | |
| H'FFC0 | P9DDR | P97DDR | P96DDR | P95DDR | P94DDR | P93DDR | P92DDR | P91DDR | P90DDR | | |
| H'FFC1 | P9DR | P97DR | P96DR | P95DR | P94DR | P93DR | P92DR | P91DR | P90DR | | |
| H'FFC2 | IER | IRQ7E | IRQ6E | IRQ5E | IRQ4E | IRQ3E | IRQ2E | IRQ1E | IRQ0E | Interrupt controller | 8 |
| H'FFC3 | STCR | — | IICX1 | IICX0 | IICE | FLSHE | — | ICKS1 | ICKS0 | System | 8 |
| H'FFC4 | SYSCR | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME | | |
| H'FFC5 | MDCR | EXPE | — | — | — | — | — | MDS1 | MDS0 | | |
| H'FFC6 | BCR | ICIS1 | ICIS0 | BRSTRM | BRSTS1 | BRSTS0 | — | IOS1 | IOS0 | Bus controller | 8 |
| H'FFC7 | WSCR | RAMS | RAM0 | ABW | AST | WMS1 | WMS0 | WC1 | WC0 | | |
| H'FFC8 | TCR0 | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMR0, TMR1 | 16 |
| H'FFC9 | TCR1 | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | | |
| H'FFCA | TCSR0 | CMFB | CMFA | OVF | ADTE | OS3 | OS2 | OS1 | OS0 | | |
| H'FFCB | TCSR1 | CMFB | CMFA | OVF | — | OS3 | OS2 | OS1 | OS0 | | |
| H'FFCC | TCORA0 | | | | | | | | | | |
| H'FFCD | TCORA1 | | | | | | | | | | |
| H'FFCE | TCORB0 | | | | | | | | | | |
| H'FFCF | TCORB1 | | | | | | | | | | |
| H'FFD0 | TCNT0 | | | | | | | | | | |
| H'FFD1 | TCNT1 | | | | | | | | | | |
| H'FFD2 | PWOERB | OE15 | OE14 | OE13 | OE12 | OE11 | OE10 | OE9 | OE8 | PWM | 8 |
| H'FFD3 | PWOERA | OE7 | OE6 | OE5 | OE4 | OE3 | OE2 | OE1 | OE0 | | |
| H'FFD4 | PWDPRB | OS15 | OS14 | OS13 | OS12 | OS11 | OS10 | OS9 | OS8 | | |
| H'FFD5 | PWDpra | OS7 | OS6 | OS5 | OS4 | OS3 | OS2 | OS1 | OS0 | | |
| H'FFD6 | PWSL | PWCKE | PWCKS | — | — | RS3 | RS2 | RS1 | RS0 | | |
| H'FFD7 | PWDR0 to PWDR15 | | | | | | | | | | |
| H'FFD8 | SMR0 | C/ \bar{A} | CHR | PE | O/ \bar{E} | STOP | MP | CKS1 | CKS0 | SCIO | 8 |
| | ICCR0 | ICE | IEIC | MST | TRS | ACKE | BBSY | IRIC | SCP | IIC0 | |
| H'FFD9 | BRR0 | | | | | | | | | SCIO | |
| | ICSR0 | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | IIC0 | |

Appendix B Internal I/O Registers

| Address | Register | | | | | | | | | Module Name | Bus Width |
|---------|------------------|--------|--------|--------|--------|---------|--------|--------|--------|----------------------|-----------|
| | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| H'FFDA | SCR0 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | SCI0 | 8 |
| H'FFDB | TDR0 | | | | | | | | | | |
| H'FFDC | SSR0 | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT | | |
| H'FFDD | RDR0 | | | | | | | | | | |
| H'FFDE | SCMR0 | — | — | — | — | SDIR | SINV | — | SMIF | | |
| | ICDR0 | ICDR7 | ICDR6 | ICDR5 | ICDR4 | ICDR3 | ICDR2 | ICDR1 | ICDR0 | IIC0 | |
| | SARX0 | SVAX6 | SVAX5 | SVAX4 | SVAX3 | SVAX2 | SVAX1 | SVAX0 | FSX | | |
| H'FFDF | ICMR0 | MLS | WAIT | CKS2 | CKS1 | CKS0 | BC2 | BC1 | BC0 | | |
| | SAR0 | SVA6 | SVA5 | SVA4 | SVA3 | SVA2 | SVA1 | SVA0 | FS | | |
| H'FFE0 | ADDRAH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | A/D | 8 |
| H'FFE1 | ADDRAL | AD1 | AD0 | — | — | — | — | — | — | | |
| H'FFE2 | ADDRBH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | | |
| H'FFE3 | ADDRBL | AD1 | AD0 | — | — | — | — | — | — | | |
| H'FFE4 | ADDRCH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | | |
| H'FFE5 | ADDRCL | AD1 | AD0 | — | — | — | — | — | — | | |
| H'FFE6 | ADDRDH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | | |
| H'FFE7 | ADDRDL | AD1 | AD0 | — | — | — | — | — | — | | |
| H'FFE8 | ADCSR | ADF | ADIE | ADST | SCAN | CKS | CH2 | CH1 | CH0 | | |
| H'FFE9 | ADCR | TRGS1 | TRGS0 | — | — | — | — | — | — | | |
| H'FFEA | TCSR1 | OVF | WT/IT | TME | PSS | RST/NMI | CKS2 | CKS1 | CKS0 | WDT1 | 16 |
| | TCNT1 (write) | | | | | | | | | | |
| H'FFEB | TCNT1 (read) | | | | | | | | | | |
| H'FFF0 | HICR | — | — | — | — | — | IBFIE2 | IBFIE1 | FGA20E | HIF | 8 |
| | TCRX | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMRX | |
| | TCRY | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMRX | |
| H'FFF1 | KMIMR | KMIMR7 | KMIMR6 | KMIMR5 | KMIMR4 | KMIMR3 | KMIMR2 | KMIMR1 | KMIMR0 | Interrupt controller | |
| | TCSRX | CMFB | CMFA | OVF | ICF | OS3 | OS2 | OS1 | OS0 | TMRX | |
| | TCSRY | CMFB | CMFA | OVF | ICIE | OS3 | OS2 | OS1 | OS0 | TMRX | |
| H'FFF2 | KMPCR | KM7PCR | KM6PCR | KM5PCR | KM4PCR | KM3PCR | KM2PCR | KM1PCR | KM0PCR | Ports | |
| | TICRR | | | | | | | | | TMRX | |
| | TCORAY | | | | | | | | | TMRX | |
| H'FFF3 | TICRF | | | | | | | | | TMRX | |
| | TCORBY | | | | | | | | | TMRX | |
| H'FFF4 | IDR1 | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 | HIF | |
| | TCNTX | | | | | | | | | TMRX | |
| | TCNTY | | | | | | | | | TMRX | |

| Address | Register | | | | | | | | | Module Name | Bus Width |
|---------|----------|--------|--------|--------|--------|--------------|--------|--------|--------|------------------|-----------|
| | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | | |
| H'FFF5 | ODR1 | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 | HIF | 8 |
| | TCORC | | | | | | | | | TMRX | |
| | TISR | — | — | — | — | — | — | — | IS | TMRY | |
| H'FFF6 | STR1 | DBU | DBU | DBU | DBU | C/ \bar{D} | DBU | IBF | OBF | HIF | |
| | TCORAX | | | | | | | | | TMRX | |
| H'FFF7 | TCORBX | | | | | | | | | | |
| H'FFF8 | DADR0 | | | | | | | | | D/A | |
| H'FFF9 | DADR1 | | | | | | | | | | |
| H'FFFA | DACR | DAOE1 | DAOE0 | DAE | — | — | — | — | — | | |
| H'FFFC | IDR2 | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 | HIF | |
| | TCONRI | SIMOD1 | SIMOD0 | SCONE | ICST | HFINV | VFINV | HIINV | VIINV | Timer connection | |
| H'FFFD | ODR2 | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 | HIF | |
| | TCONRO | HOE | VOE | CLOE | CBOE | HOINV | VOINV | CLOINV | CBOINV | Timer connection | |
| H'FFFE | STR2 | DBU | DBU | DBU | DBU | C/ \bar{D} | DBU | IBF | OBF | HIF | |
| | TCONRS | TMRX/Y | ISGENE | HOMOD1 | HOMOD0 | VOMOD1 | VOMOD0 | CLMOD1 | CLMOD0 | Timer connection | |
| H'FFFF | SEDGR | VEDG | HEDG | CEDG | HFEDG | VFEDG | PREQF | IHI | IVI | | |

B.2 Register Selection Conditions

| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | H8S/2134 Group Register Selection Conditions | Module Name |
|------------------|---------------|--|--|---------------------------|
| H'EC00 to H'FFFF | MRA | RAME = 1 in SYSCR | — | DTC |
| | SAR | | | |
| | MRB | | | |
| | DAR | | | |
| | CRA | | | |
| | CRB | | | |
| H'FEE4 | KBCOMP | No conditions | No conditions | IrDA/ expansion A/D |
| H'FEE6 | DDCSWR | MSTP4 = 0 | — | IIC0 |
| H'FEE8 | ICRA | No conditions | No conditions | Interrupt controller |
| H'FEE9 | ICRB | | | |
| H'FEEA | ICRC | | | |
| H'FEEB | ISR | | | |
| H'FEEC | ISCRH | | | |
| H'FEED | ISCR L | | | |
| H'FEEE | DTCERA | | | |
| H'FEEF | DTCERB | | | |
| H'FEF0 | DTCERC | | | |
| H'FEF1 | DTCERD | | | |
| H'FEF2 | DTCERE | | | |
| H'FEF3 | DTCERF | | | |
| H'FEF4 | ABRKCR | No conditions | No conditions | Interrupt controller |
| H'FEF5 | BARA | | | |
| H'FEF6 | BARB | | | |
| H'FEF7 | BARC | | | |
| H'FF80 | FLMCR1 | FLSHE = 1 in STCR | FLSHE = 1 in STCR | Flash memory |
| H'FF81 | FLMCR2 | | | |
| H'FF82 | PCSR | FLSHE = 0 in STCR | FLSHE = 0 in STCR | PWM |
| | EBR1 | FLSHE = 1 in STCR | FLSHE = 1 in STCR | Flash memory |
| H'FF83 | SYSCR2 | FLSHE = 0 in STCR | — | HIF |
| | EBR2 | FLSHE = 1 in STCR | FLSHE = 1 in STCR | Flash memory |
| H'FF84 | SBYCR | FLSHE = 0 in STCR | FLSHE = 0 in STCR | System |
| H'FF85 | LPWRCR | | | |
| H'FF86 | MSTPCR H | | | |
| H'FF87 | MSTPCR L | | | |
| | | | | |

| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | | H8S/2134 Group Register Selection Conditions | | Module Name | | |
|---------------|---------------|--|------------------|--|---|-------------|-----------------------------|------------------|
| H'FF88 | SMR1 | MSTP6 = 0, IICE = 0 in STCR | | MSTP6 = 0, IICE = 0 in STCR | | SCI1 | | |
| | ICCR1 | MSTP3 = 0, IICE = 1 in STCR | | — | | IIC1 | | |
| H'FF89 | BRR1 | MSTP6 = 0, IICE = 0 in STCR | | MSTP6 = 0, IICE = 0 in STCR | | SCI1 | | |
| | ICSR1 | MSTP3 = 0, IICE = 1 in STCR | | — | | IIC1 | | |
| H'FF8A | SCR1 | MSTP6 = 0 | | MSTP6 = 0 | | SCI1 | | |
| H'FF8B | TDR1 | | | | | | | |
| H'FF8C | SSR1 | | | | | | | |
| H'FF8D | RDR1 | | | | | | | |
| H'FF8E | SCMR1 | | | | | | MSTP6 = 0, IICE = 0 in STCR | |
| H'FF8E | ICDR1 | MSTP3 = 0, IICE = 1 in STCR | | ICE = 1 in ICCR1 | — | IIC1 | | |
| | SARX1 | | | | | | ICE = 0 in ICCR1 | |
| H'FF8F | ICMR1 | | | ICE = 1 in ICCR1 | | | | |
| | SAR1 | | | ICE = 0 in ICCR1 | | | | |
| H'FF90 | TIER | MSTP13 = 0 | | MSTP13 = 0 | | FRT | | |
| H'FF91 | TCSR | | | | | | | |
| H'FF92 | FRCH | | | | | | | |
| H'FF93 | FRCL | | | | | | | |
| H'FF94 | OCRAH | | | | | | OCRS = 0 in TOCR | OCRS = 0 in TOCR |
| | OCRBH | | | | | | OCRS = 1 in TOCR | OCRS = 1 in TOCR |
| H'FF95 | OCRAL | | | | | | OCRS = 0 in TOCR | OCRS = 0 in TOCR |
| | OCRBL | | | | | | OCRS = 1 in TOCR | OCRS = 1 in TOCR |
| H'FF96 | TCR | | | | | | | |
| H'FF97 | TOCR | | | | | | | |
| H'FF98 | ICRAH | | | | | | ICRS = 0 in TOCR | ICRS = 0 in TOCR |
| | OCRARH | | | | | | ICRS = 1 in TOCR | ICRS = 1 in TOCR |
| H'FF99 | ICRAL | | | | | | ICRS = 0 in TOCR | ICRS = 0 in TOCR |
| | OCRARL | | | | | | ICRS = 1 in TOCR | ICRS = 1 in TOCR |
| H'FF9A | ICRBH | | | | | | ICRS = 0 in TOCR | ICRS = 0 in TOCR |
| | OCRAFH | ICRS = 1 in TOCR | ICRS = 1 in TOCR | | | | | |

| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | | H8S/2134 Group Register Selection Conditions | | Module Name | |
|---------------|---------------|--|--|--|--|-------------------------|-------------------------|
| H'FF9B | ICRBL | MSTP13 = 0 | | MSTP13 = 0 | | FRT | |
| | OCRAFL | | | | | | ICRS = 0 in TOCR |
| H'FF9C | ICRCH | MSTP13 = 0 | | MSTP13 = 0 | | | ICRS = 1 in TOCR |
| | OCRDMH | | | | | | ICRS = 0 in TOCR |
| H'FF9D | ICRCL | MSTP13 = 0 | | MSTP13 = 0 | | | ICRS = 1 in TOCR |
| | OCRDML | | | | | | ICRS = 0 in TOCR |
| H'FF9E | ICRDH | MSTP13 = 0 | | MSTP13 = 0 | | ICRS = 1 in TOCR | |
| H'FF9F | ICRDL | | | | | ICRS = 0 in TOCR | ICRS = 0 in TOCR |
| H'FFA0 | SMR2 | MSTP5 = 0, IICE = 0 in STCR | | MSTP5 = 0, IICE = 0 in STCR | | SCI2 | |
| H'FFA0 | DADRAH | MSTP11 = 0, IICE = 1 in STCR | | MSTP11 = 0, IICE = 1 in STCR | | PWMX | |
| | DACR | | | | | | REGS = 0 in DACNT/DADRB |
| H'FFA1 | BRR2 | MSTP5 = 0, IICE = 0 in STCR | | MSTP5 = 0, IICE = 0 in STCR | | SCI2 | |
| H'FFA1 | DADRAL | MSTP11 = 0, IICE = 1 in STCR | | MSTP11 = 0, IICE = 1 in STCR | | PWMX | |
| H'FFA2 | SCR2 | MSTP5 = 0 | | MSTP5 = 0 | | SCI2 | |
| H'FFA3 | TDR2 | | | | | | |
| H'FFA4 | SSR2 | | | | | | |
| H'FFA5 | RDR2 | | | | | | |
| H'FFA6 | SCMR2 | MSTP5 = 0, IICE = 0 in STCR | | MSTP5 = 0, IICE = 0 in STCR | | PWMX | |
| H'FFA6 | DADRBH | MSTP11 = 0, IICE = 1 in STCR | | MSTP11 = 0, IICE = 1 in STCR | | | |
| | DACNTH | | | | | | REGS = 0 in DACNT/DADRB |
| H'FFA7 | DADRBL | MSTP11 = 0, IICE = 1 in STCR | | MSTP11 = 0, IICE = 1 in STCR | | | REGS = 1 in DACNT/DADRB |
| | DACNTL | | | | | REGS = 0 in DACNT/DADRB | REGS = 0 in DACNT/DADRB |
| H'FFA8 | TCSR0 | No conditions | | No conditions | | WDT0 | |
| | TCNT0 (write) | | | | | | |
| H'FFA9 | TCNT0 (read) | No conditions | | No conditions | | | |

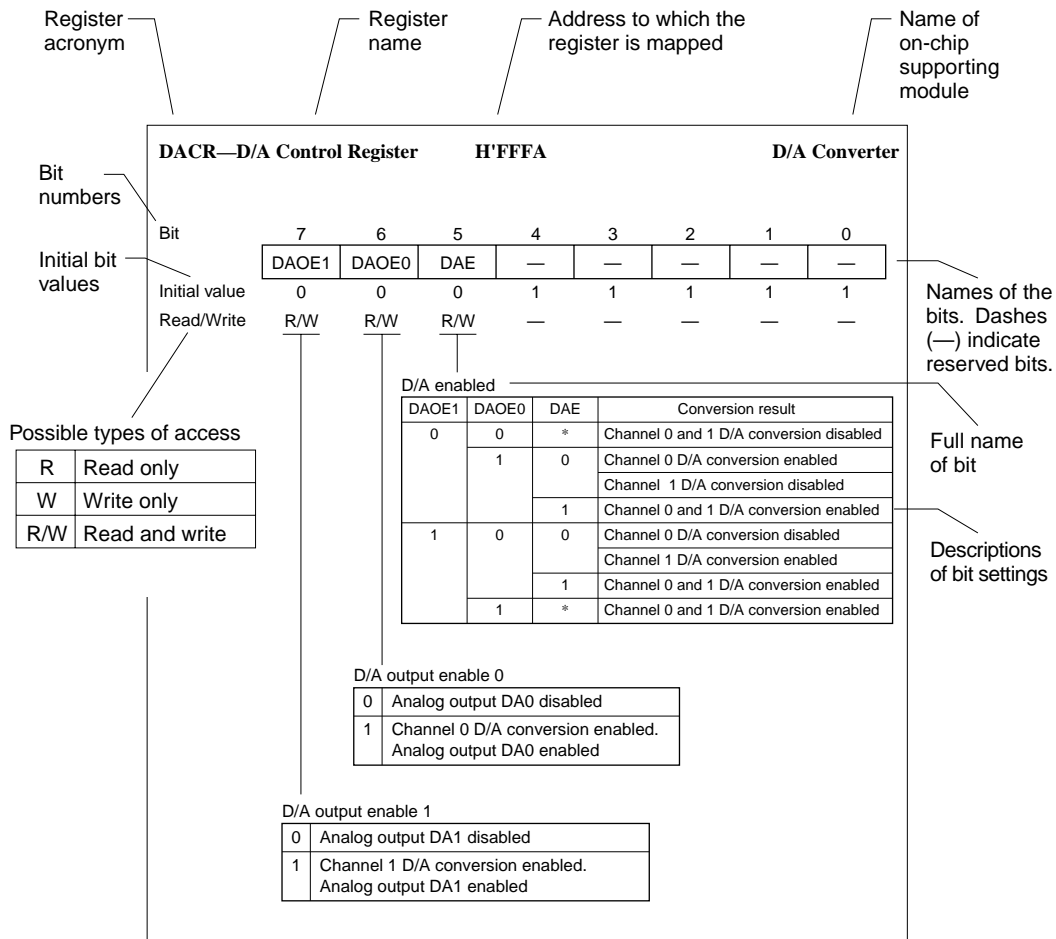
| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | H8S/2134 Group Register Selection Conditions | Module Name |
|---------------|---------------|--|--|----------------------|
| H'FFAC | P1PCR | No conditions | No conditions | Ports |
| H'FFAD | P2PCR | | | |
| H'FFAE | P3PCR | | | |
| H'FFB0 | P1DDR | | | |
| H'FFB1 | P2DDR | | | |
| H'FFB2 | P1DR | | | |
| H'FFB3 | P2DR | | | |
| H'FFB4 | P3DDR | | | |
| H'FFB5 | P4DDR | | | |
| H'FFB6 | P3DR | | | |
| H'FFB7 | P4DR | | | |
| H'FFB8 | P5DDR | | | |
| H'FFB9 | P6DDR | | | |
| H'FFBA | P5DR | | | |
| H'FFBB | P6DR | | | |
| H'FFBD | P8DDR | | | |
| H'FFBE | P7PIN | | | |
| H'FFBF | P8DR | | | |
| H'FFC0 | P9DDR | | | |
| H'FFC1 | P9DR | | | |
| H'FFC2 | IER | No conditions | No conditions | Interrupt controller |
| H'FFC3 | STCR | No conditions | No conditions | System |
| H'FFC4 | SYSCR | | | |
| H'FFC5 | MDCR | | | |
| H'FFC6 | BCR | | | |
| H'FFC7 | WSCR | | | |
| H'FFC8 | TCR0 | MSTP12 = 0 | MSTP12 = 0 | TMR0, TMR1 |
| H'FFC9 | TCR1 | | | |
| H'FFCA | TCSR0 | | | |
| H'FFCB | TCSR1 | | | |
| H'FFCC | TCORA0 | | | |
| H'FFCD | TCORA1 | | | |
| H'FFCE | TCORB0 | | | |
| H'FFCF | TCORB1 | | | |
| H'FFD0 | TCNT0 | | | |
| H'FFD1 | TCNT1 | | | |

| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | | H8S/2134 Group Register Selection Conditions | Module Name | |
|---------------|-----------------|--|--|--|-------------|-----------------------------|
| H'FFD2 | PWOERB | No conditions | | — | PWM | |
| H'FFD3 | PWOERA | | | | | |
| H'FFD4 | PWDPRB | | | | | |
| H'FFD5 | PWDPRA | | | | | |
| H'FFD6 | PWSL | | | | | |
| H'FFD7 | PWDR0 to PWDR15 | MSTP11 = 0 | | | | |
| H'FFD8 | SMR0 | MSTP7 = 0, IICE = 0 in STCR | | MSTP7 = 0, IICE = 0 in STCR | SC10 | |
| | ICCR0 | MSTP4 = 0, IICE = 1 in STCR | | — | IIC0 | |
| H'FFD9 | BRR0 | MSTP7 = 0, IICE = 0 in STCR | | MSTP7 = 0, IICE = 0 in STCR | SC10 | |
| | ICSR0 | MSTP4 = 0, IICE = 1 in STCR | | — | IIC0 | |
| H'FFDA | SCR0 | MSTP7 = 0 | | MSTP7 = 0 | SC10 | |
| H'FFDB | TDR0 | | | | | |
| H'FFDC | SSR0 | | | | | |
| H'FFDD | RDR0 | | | | | |
| H'FFDE | SCMR0 | | | | | MSTP7 = 0, IICE = 0 in STCR |
| | ICDR0 | MSTP4 = 0, IICE = 1 in STCR | | — | IIC0 | |
| | SARX0 | | | | | ICE = 1 in ICCR0 |
| | | | | | | ICE = 0 in ICCR0 |
| H'FFDF | ICMR0 | | | | | ICE = 1 in ICCR0 |
| | SAR0 | | | ICE = 0 in ICCR0 | | |
| H'FFE0 | ADDRAH | MSTP9 = 0 | | MSTP9 = 0 | A/D | |
| H'FFE1 | ADDRAL | | | | | |
| H'FFE2 | ADDRBH | | | | | |
| H'FFE3 | ADDRBL | | | | | |
| H'FFE4 | ADDRCH | | | | | |
| H'FFE5 | ADDRCL | | | | | |
| H'FFE6 | ADDRDH | | | | | |
| H'FFE7 | ADDRDL | | | | | |
| H'FFE8 | ADCSR | | | | | |
| H'FFE9 | ADCR | | | | | |
| H'FFEA | TCSR1 | | | | | No conditions |
| | TCNT1 (write) | | | | | |
| H'FFEB | TCNT1 (read) | | | | | |

| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | | H8S/2134 Group Register Selection Conditions | Module Name |
|---------------|---------------|--|----------------------|--|-----------------------------|
| H'FFF0 | HICR | MSTP2 = 0, HIE = 1 in SYSCR | | — | HIF |
| | TCRX | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | | TMRX |
| | TCRY | | TMRX/Y = 1 in TCONRS | | TMRX |
| H'FFF1 | KMIMR | MSTP2 = 0, HIE = 1 in SYSCR | | MSTP2 = 0, HIE = 1 in SYSCR | Interrupt controller |
| | TCSRX | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | — | TMRX |
| | TCSRY | | TMRX/Y = 1 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX |
| H'FFF2 | KMPCR | MSTP2 = 0, HIE = 1 in SYSCR | | MSTP2 = 0, HIE = 1 in SYSCR | Ports |
| | TICRR | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | — | TMRX |
| | TCORAY | | TMRX/Y = 1 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX |
| H'FFF3 | TICRF | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | — | TMRX |
| | TCORBY | | TMRX/Y = 1 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX |
| H'FFF4 | IDR1 | MSTP2 = 0, HIE = 1 in SYSCR | | — | HIF |
| | TCNTX | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | | TMRX |
| | TCNTY | | TMRX/Y = 1 in TCONRS | | MSTP8 = 0, HIE = 0 in SYSCR |
| H'FFF5 | ODR1 | MSTP2 = 0, HIE = 1 in SYSCR | | — | HIF |
| | TCORC | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | | TMRX |
| | TISR | | TMRX/Y = 1 in TCONRS | | MSTP8 = 0, HIE = 0 in SYSCR |
| H'FFF6 | STR1 | MSTP2 = 0, HIE = 1 in SYSCR | | — | HIF |
| | TCORAX | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | | TMRX |
| H'FFF7 | TCORBX | | | | |
| H'FFF8 | DADR0 | MSTP10 = 0 | | MSTP10 = 0 | D/A |
| H'FFF9 | DADR1 | | | | |
| H'FFFA | DACR | | | | |

| Lower Address | Register Name | H8S/2138 Group Register Selection Conditions | H8S/2134 Group Register Selection Conditions | Module Name |
|---------------|---------------|--|--|------------------|
| H'FFFC | IDR2 | MSTP2 = 0, HIE = 1 in SYSCR | — | HIF |
| | TCONRI | MSTP8 = 0, HIE = 0 in SYSCR | | Timer connection |
| H'FFFD | ODR2 | MSTP2 = 0, HIE = 1 in SYSCR | | HIF |
| | TCONRO | MSTP8 = 0, HIE = 0 in SYSCR | | Timer connection |
| H'FFFE | STR2 | MSTP2 = 0, HIE = 1 in SYSCR | — | HIF |
| | TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | | Timer connection |
| H'FFFF | SEDGR | | | |

B.3 Functions



MRA—DTC Mode Register A

H'EC00–H'EFFF

DTC

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | SM1 | SM0 | DM1 | DM0 | MD1 | MD0 | DTS | Sz |
| Initial value | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined |
| Read/Write | — | — | — | — | — | — | — | — |

| DTC data transfer size | |
|------------------------|--------------------|
| 0 | Byte-size transfer |
| 1 | Word-size transfer |

| DTC transfer mode select | |
|--------------------------|---|
| 0 | Destination side is repeat area or block area |
| 1 | Source side is repeat area or block area |

| DTC mode | | |
|----------|---|---------------------|
| 0 | 0 | Normal mode |
| | 1 | Repeat mode |
| 1 | 0 | Block transfer mode |
| | 1 | — |

| Destination address mode | | |
|--------------------------|---|--|
| 0 | — | DAR is fixed |
| 1 | 0 | DAR is incremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |
| | 1 | DAR is decremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |

| Source address mode | | |
|---------------------|---|--|
| 0 | — | SAR is fixed |
| 1 | 0 | SAR is incremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |
| | 1 | SAR is decremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1) |

MRB—DTC Mode Register B**H'EC00–H'EFFF****DTC**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| | CHNE | DISEL | — | — | — | — | — | — |
| Initial value | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined | Undefined |
| Read/Write | — | — | — | — | — | — | — | — |

| DTC interrupt select | |
|----------------------|--|
| 0 | After a data transfer ends, the CPU interrupt is disabled unless the transfer counter is 0 |
| 1 | After a data transfer ends, the CPU interrupt is enabled |

| DTC chain transfer enable | |
|---------------------------|--------------------------|
| 0 | End of DTC data transfer |
| 1 | DTC chain transfer |

SAR—DTC Source Address Register**H'EC00–H'EFFF****DTC**

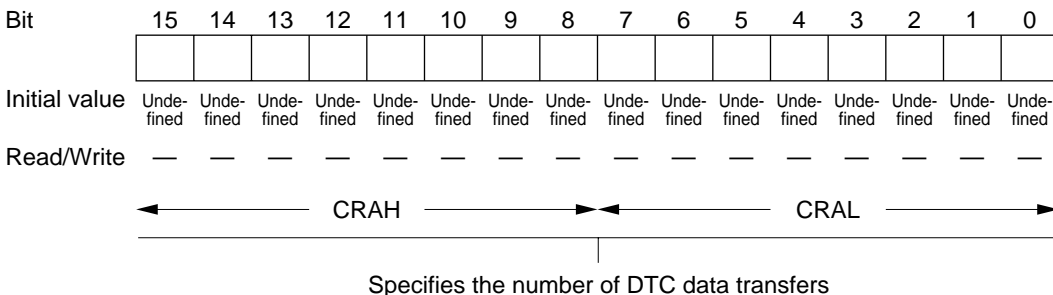
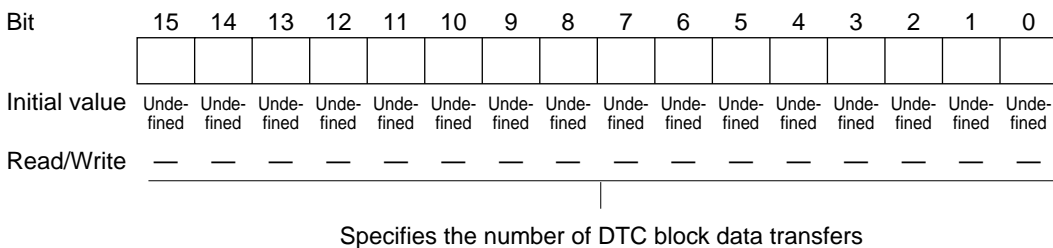
| Bit | 23 | 22 | 21 | 20 | 19 | --- | 4 | 3 | 2 | 1 | 0 |
|---------------|----------------|----------------|----------------|----------------|----------------|-----|----------------|----------------|----------------|----------------|----------------|
| | | | | | | --- | | | | | |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | --- | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/Write | — | — | — | — | — | --- | — | — | — | — | — |

Specifies DTC transfer data source address

DAR—DTC Destination Address Register**H'EC00–H'EFFF****DTC**

| Bit | 23 | 22 | 21 | 20 | 19 | --- | 4 | 3 | 2 | 1 | 0 |
|---------------|----------------|----------------|----------------|----------------|----------------|-----|----------------|----------------|----------------|----------------|----------------|
| | | | | | | --- | | | | | |
| Initial value | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined | --- | Unde- fined | Unde- fined | Unde- fined | Unde- fined | Unde- fined |
| Read/Write | — | — | — | — | — | --- | — | — | — | — | — |

Specifies DTC transfer data destination address

CRA—DTC Transfer Count Register A **H'EC00–H'EFF** **DTC****CRB—DTC Transfer Count Register B** **H'EC00–H'EFF** **DTC**

KBCOMP—Keyboard Comparator Control Register H'FEE4 IrDA/Expansion A/D

| | | | | | | | | |
|---------------|-----|--------|--------|--------|-------|-------|-------|-------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IrE | IrCKS2 | IrCKS1 | IrCKS0 | KBADE | KBCH2 | KBCH1 | KBCH0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Keyboard comparator control

| Bit 3 | Bit 2 | Bit 1 | Bit 0 | A/D converter channel 6 input | A/D converter channel 7 input | |
|-------|-------|-------|-------|-------------------------------|-------------------------------|------|
| KBADE | KBCH2 | KBCH1 | KBCH0 | | | |
| 0 | — | — | — | AN6 | AN7 | |
| 1 | 0 | 0 | 0 | CIN0 | Undefined | |
| | | | 1 | CIN1 | | |
| | | 1 | 0 | CIN2 | | |
| | | | 1 | CIN3 | | |
| | 1 | 0 | 0 | 0 | | CIN4 |
| | | | | 1 | | CIN5 |
| | | 1 | 0 | 0 | | CIN6 |
| | | | | 1 | | CIN7 |

IrDA Clock select 2 to 0

| | | | |
|---|---|---|--|
| 0 | 0 | 0 | $B \times 3/16$ (3/16 of the bit rate) |
| | | 1 | $\phi/2$ |
| | 1 | 0 | $\phi/4$ |
| | | 1 | $\phi/8$ |
| 1 | 0 | 0 | $\phi/16$ |
| | | 1 | $\phi/32$ |
| | 1 | 0 | $\phi/64$ |
| | | 1 | $\phi/128$ |

IrDA enable

| | |
|---|--|
| 0 | The TxD2/IrTxD and RxD2/IrRxD pins function as TxD2 and RxD2 |
| 1 | The TxD2/IrTxD and RxD2/IrRxD pins function as IrTxD and IrRxD |

DDCSWR—DDC Switch Register

H'FEE6

IIC0

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|---------|------|------|------|------|
| | SWE | SW | IE | IF | CLR3 | CLR2 | CLR1 | CLR0 |
| Initial value | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/(W)*1 | W*2 | W*2 | W*2 | W*2 |

IIC clear bits

| Bit 3 | Bit 2 | Bit 1 | Bit 0 | Description |
|-------|-------|-------|-------|--|
| CLR3 | CLR2 | CLR1 | CLR0 | |
| 0 | 0 | — | — | Setting prohibited |
| | 1 | 0 | 0 | Setting prohibited |
| | | | 1 | IIC0 internal latch cleared |
| | | 1 | 0 | IIC1 internal latch cleared |
| | | | 1 | IIC0 and IIC1 internal latches cleared |
| 1 | — | — | — | Invalid setting |

DDC mode switch interrupt flag

| | |
|---|---|
| 0 | No interrupt is requested when automatic format switching is executed [Clearing condition] When 0 is written in IF after reading IF = 1 |
| 1 | An interrupt is requested when automatic format switching is executed [Setting condition] When a falling edge is detected on the SCL pin when SWE = 1 |

DDC mode switch interrupt enable bit

| | |
|---|---|
| 0 | Interrupt when automatic format switching is executed is disabled |
| 1 | Interrupt when automatic format switching is executed is enabled |

DDC mode switch

| | |
|---|--|
| 0 | IIC channel 0 is used with the I ² C bus format [Clearing conditions] <ul style="list-style-type: none"> When 0 is written by software When a falling edge is detected on the SCL pin when SWE = 1 |
| 1 | IIC channel 0 is used in formatless mode [Setting condition] When 1 is written in SW after reading SW = 0 |

DDC mode switch enable

| | |
|---|--|
| 0 | Automatic switching of IIC channel 0 from formatless mode to I ² C bus format is disabled |
| 1 | Automatic switching of IIC channel 0 from formatless mode to I ² C bus format is enabled |

- Notes: 1. Only 0 can be written, to clear the flag.
2. Always read as 1.

ICRA—Interrupt Control Register A**H'FEE8****Interrupt Controller****ICRB—Interrupt Control Register B****H'FEE9****Interrupt Controller****ICRC—Interrupt Control Register C****H'FEEA****Interrupt Controller**

| | | | | | | | | |
|---------------|------|------|------|------|------|------|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Interrupt control level

| | |
|---|--|
| 0 | Corresponding interrupt source is control level 0 (non-priority) |
| 1 | Corresponding interrupt source is control level 1 (priority) |

Correspondence between Interrupt Sources and ICR Settings

| Register | Bits | | | | | | | |
|----------|------------------|---------------------------|------------------|------------------------------|------------------------------|--------------------------|---------------------------------|---------------------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| ICRA | IRQ0 | IRQ1 | IRQ2 IRQ3 | IRQ4 IRQ5 | IRQ6 IRQ7 | DTC | Watchdog timer 0 | Watchdog timer 1 |
| ICRB | A/D converter | Free- running timer | — | — | 8-bit timer channel 0 | 8-bit timer channel 1 | 8-bit timer channels X, Y | HIF |
| ICRC | SCI channel 0 | SCI channel 1 | SCI channel 2 | IIC channel 0 (option) | IIC channel 1 (option) | — | — | — |

ISR—IRQ Status Register

H'FEEB

Interrupt Controller

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | IRQ7F | IRQ6F | IRQ5F | IRQ4F | IRQ3F | IRQ2F | IRQ1F | IRQ0F |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* |

IRQ7 to IRQ0 flags

| | |
|---|---|
| 0 | <p>[Clearing conditions]</p> <ul style="list-style-type: none"> • Cleared by reading IRQnF when set to 1, then writing 0 in IRQnF • When interrupt exception handling is executed when low-level detection is set (IRQnSCB = IRQnSCA = 0) and $\overline{\text{IRQn}}$ input is high* • When IRQn interrupt exception handling is executed when falling, rising, or both-edge detection is set (IRQnSCB = 1 or IRQnSCA = 1)* |
| 1 | <p>[Setting conditions]</p> <ul style="list-style-type: none"> • When $\overline{\text{IRQn}}$ input goes low when low-level detection is set (IRQnSCB = IRQnSCA = 0) • When a falling edge occurs in $\overline{\text{IRQn}}$ input when falling edge detection is set (IRQnSCB = 0, IRQnSCA = 1) • When a rising edge occurs in $\overline{\text{IRQn}}$ input when rising edge detection is set (IRQnSCB = 1, IRQnSCA = 0) • When a falling or rising edge occurs in $\overline{\text{IRQn}}$ input while both-edge detection is set (IRQnSCB = IRQnSCA = 1) |

(n = 7 to 0)

Note: * When a product, in which a DTC is incorporated, is used in the following settings, the corresponding flag bit is not automatically cleared even when exception handling, which is a clear condition, is executed and the bit is held at 1.

- (1) When DTCEA3 is set to 1 (ADI is set to an interrupt source) IRQ4F flag is not automatically cleared.
- (2) When DTCEA2 is set to 1 (ICIA is set to an interrupt source) IRQ5F flag is not automatically cleared.
- (3) When DTCEA1 is set to 1 (ICIB is set to an interrupt source) IRQ6F flag is not automatically cleared.
- (4) When DTCEA0 is set to 1 (OCIA is set to an interrupt source) IRQ7F flag is not automatically cleared.

When activation interrupt sources of DTC and IRQ interrupts are used with the above combinations, clear the interrupt flag by software in the interrupt handling routine of the corresponding IRQ.

Note: * Only 0 can be written, to clear the flag.

ISCRH—IRQ Sense Control Register H

H'FEEC

Interrupt Controller

ISCR L—IRQ Sense Control Register L

H'FEED

Interrupt Controller

ISCRH

| | | | | | | | | |
|---------------|---------|---------|---------|---------|---------|---------|---------|---------|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | IRQ7SCB | IRQ7SCA | IRQ6SCB | IRQ6SCA | IRQ5SCB | IRQ5SCA | IRQ4SCB | IRQ4SCA |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
IRQ7 to IRQ4 sense control A and B

ISCR L

| | | | | | | | | |
|---------------|---------|---------|---------|---------|---------|---------|---------|---------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IRQ3SCB | IRQ3SCA | IRQ2SCB | IRQ2SCA | IRQ1SCB | IRQ1SCA | IRQ0SCB | IRQ0SCA |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
IRQ3 to IRQ0 sense control A and B

| ISCRH bits 7 to 0 ISCR L bits 7 to 0 | | Description |
|---|-----------------------|--|
| IRQ7SCB to IRQ0SCB | IRQ7SCA to IRQ0SCA | |
| 0 | 0 | Interrupt request generated at $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input at low level |
| | 1 | Interrupt request generated at falling edge of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input |
| 1 | 0 | Interrupt request generated at rising edge of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input |
| | 1 | Interrupt request generated at both falling and rising edges of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input |

DTCEER—DTC Enable Register**H'FEEE to H'FEF2****DTC**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | DTCE7 | DTCE6 | DTCE5 | DTCE4 | DTCE3 | DTCE2 | DTCE1 | DTCE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

DTC activation enable

| | |
|---|---|
| 0 | DTC activation by interrupt is disabled [Clearing conditions] • When data transfer ends with the DISEL bit set to 1 • When the specified number of transfers end |
| 1 | DTC activation by interrupt is enabled [Holding condition] When the DISEL bit is 0 and the specified number of transfers have not ended |

DTVECR—DTC Vector Register**H'FEF3****DTC**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | SWDTE | DTVEC6 | DTVEC5 | DTVEC4 | DTVEC3 | DTVEC2 | DTVEC1 | DTVEC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Sets vector number for DTC software activation

DTC software activation enable

| | |
|---|--|
| 0 | DTC software activation is disabled [Clearing condition] When the DISEL bit is 0 and the specified number of transfers have not ended |
| 1 | DTC software activation is enabled [Holding conditions] • When data transfer ends with the DISEL bit set to 1 • When the specified number of transfers end • During software-activated data transfer |

Note: * A value of 1 can always be written to the SWDTE bit, but 0 can only be written after 1 is read.

ABRKCR—Address Break Control Register

H'FEF4

Interrupt Controller

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|---|---|---|---|---|---|-----|
| | CMF | — | — | — | — | — | — | BIE |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | — | — | — | — | — | — | R/W |

Break interrupt enable

| | |
|---|------------------------|
| 0 | Address break disabled |
| 1 | Address break enabled |

Condition match flag

| | |
|---|---|
| 0 | [Clearing condition] When address break interrupt exception handling is executed |
| 1 | [Setting condition] When address set by BARA–BARC is prefetched while BIE = 1 |

BARA—Break Address Register A**H'FEF5****Interrupt Controller****BARB—Break Address Register B****H'FEF6****Interrupt Controller****BARC—Break Address Register C****H'FEF7****Interrupt Controller**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| BARA | A23 | A22 | A21 | A20 | A19 | A18 | A17 | A16 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Specifies address (bits 23 to 16) at which address break is to be generated

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| BARB | A15 | A14 | A13 | A12 | A11 | A10 | A9 | A8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Specifies address (bits 15 to 8) at which address break is to be generated

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|---|
| BARC | A7 | A6 | A5 | A4 | A3 | A2 | A1 | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | — |

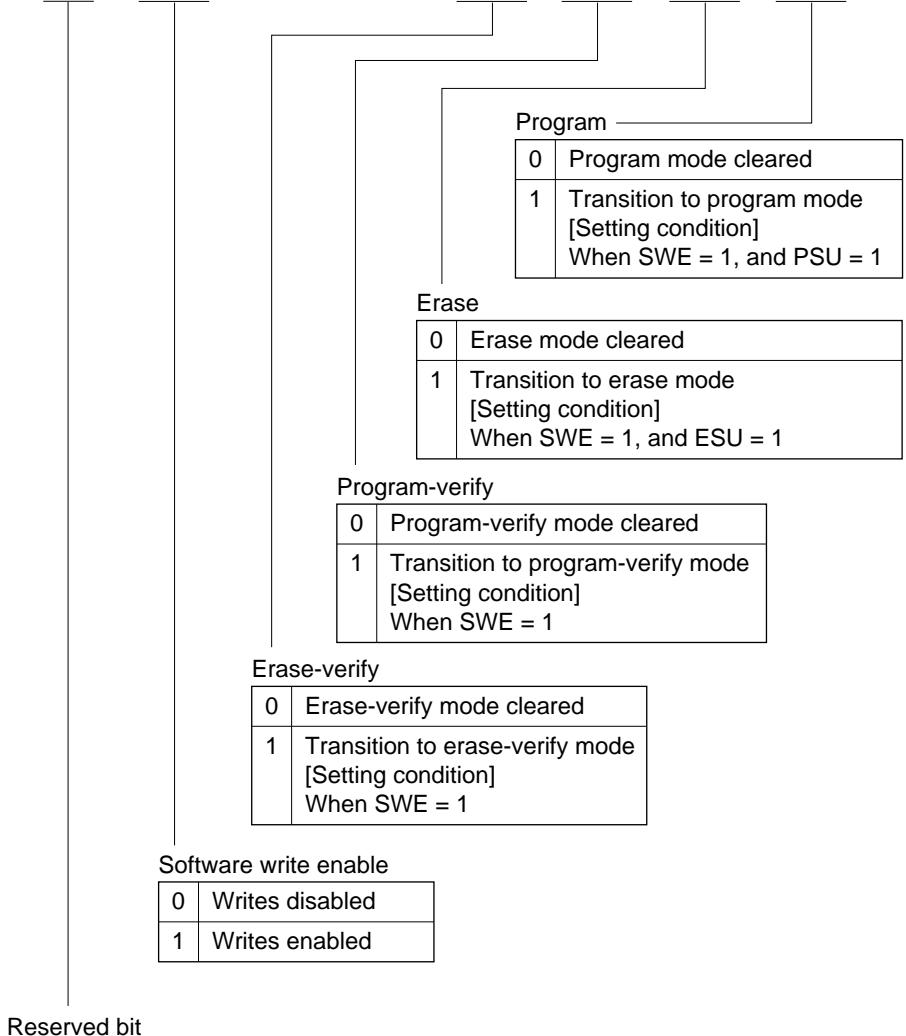
|
Specifies address (bits 7 to 1) at which address break is to be generated

FLMCR1—Flash Memory Control Register 1

H'FF80

Flash Memory

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|---|---|-----|-----|-----|-----|
| | FWE | SWE | — | — | EV | PV | E | P |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R/W | — | — | R/W | R/W | R/W | R/W |



FLMCR2—Flash Memory Control Register 2

H'FF81

Flash Memory

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|---|---|---|---|---|-----|-----|
| | FLER | — | — | — | — | — | ESU | PSU |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | — | — | — | — | — | R/W | R/W |

Program setup

| | |
|---|--|
| 0 | Program setup cleared |
| 1 | Program setup [Setting condition] When SWE = 1 |

Erase setup

| | |
|---|--|
| 0 | Erase setup cleared |
| 1 | Erase setup [Setting condition] When SWE = 1 |

Flash memory error

| | |
|---|---|
| 0 | Flash memory is operating normally Flash memory program/erase protection (error protection) is disabled [Clearing condition] Reset or hardware standby mode |
| 1 | An error has occurred during flash memory programming/erasing Flash memory program/erase protection (error protection) is enabled [Setting condition] See section 21.8.3, Error Protection |

PCSR—Peripheral Clock Select Register

H'FF82

PWM

| | | | | | | | | |
|---------------|---|---|---|---|---|-------|-------|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | — | — | — | — | — | PWCKB | PWCKA | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | R/W | R/W | — |

PWM clock select

| PWSL | | PCSR | | Description |
|-------|-------|-------|-------|-----------------------------------|
| Bit 7 | Bit 6 | Bit 2 | Bit 1 | |
| PWCKE | PWCKS | PWCKB | PWCKA | |
| 0 | — | — | — | Clock input is disabled |
| 1 | 0 | — | 0 | ϕ (system clock) is selected |
| | | | 1 | $\phi/2$ is selected |
| | 1 | 0 | 0 | $\phi/4$ is selected |
| | | | 1 | $\phi/8$ is selected |
| | | | 1 | $\phi/16$ is selected |

SYSCR2—System Control Register 2

H'FF83

HIF

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|---|-----|------|------|-------|
| | KWUL1 | KWUL0 | P6PUE | — | SDE | CS4E | CS3E | HI12E |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | — | R/W | R/W | R/W | R/W |

Host interface enable

| | |
|---|----------------------------------|
| 0 | Host interface function disabled |
| 1 | Host interface function enabled |

CS3 enable

| | |
|---|---|
| 0 | Host interface pin channel 3 functions disabled |
| 1 | Host interface pin channel 3 functions enabled |

CS4 enable

| | |
|---|---|
| 0 | Host interface pin channel 4 functions disabled |
| 1 | Host interface pin channel 4 functions enabled |

Shutdown enable

| | |
|---|---|
| 0 | Host interface pin shutdown function disabled |
| 1 | Host interface pin shutdown function enabled |

Port 6 input pull-up extra

| | |
|---|--|
| 0 | Standard current specification is selected for port 6 MOS input pull-up function |
| 1 | Current-limit specification is selected for port 6 MOS input pull-up function |

Key wakeup level 1 and 0

| | | |
|---|---|--|
| 0 | 0 | Standard input level is selected as port 6 input level |
| | 1 | Input level 1 is selected as port 6 input level |
| 1 | 0 | Input level 2 is selected as port 6 input level |
| | 1 | Input level 3 is selected as port 6 input level |

EBR1—Erase Block Register 1**H'FF82****Flash Memory****EBR2—Erase Block Register 2****H'FF83****Flash Memory**

| | | | | | | | | |
|---------------|---|---|---|---|---|---|---------|---------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | — | — | — | — | — | — | EB9/—*2 | EB8/—*2 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | — | R/W*1*2 | R/W*1*2 |

| | | | | | | | | |
|---------------|-------|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | EB7 | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W*1 | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

- Notes:
1. In normal mode, these bits cannot be modified and are always read as 0.
 2. Bits EB8 and EB9 are not present in the 64-kbyte versions; these bits cannot be modified and are always read as 0.

Erase Blocks

| Block (Size) | | Addresses |
|--------------------|-------------------|--------------------------|
| 128-kbyte versions | 64-kbyte versions | |
| EB0 (1 kbyte) | EB0 (1 kbyte) | H'(00)0000 to H'(00)03FF |
| EB1 (1 kbyte) | EB1 (1 kbyte) | H'(00)0400 to H'(00)07FF |
| EB2 (1 kbyte) | EB2 (1 kbyte) | H'(00)0800 to H'(00)0BFF |
| EB3 (1 kbyte) | EB3 (1 kbyte) | H'(00)0C00 to H'(00)0FFF |
| EB4 (28 kbytes) | EB4 (28 kbytes) | H'(00)1000 to H'(00)7FFF |
| EB5 (16 kbytes) | EB5 (16 kbytes) | H'(00)8000 to H'(00)BFFF |
| EB6 (8 kbytes) | EB6 (8 kbytes) | H'(00)C000 to H'(00)DFFF |
| EB7 (8 kbytes) | EB7 (8 kbytes) | H'00E000 to H'00FFFF |
| EB8 (32 kbytes) | — | H'010000 to H'017FFF |
| EB9 (32 kbytes) | — | H'018000 to H'01FFFF |

SBYCR—Standby Control Register

H'FF84

System

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|---|------|------|------|
| | SSBY | STS2 | STS1 | STS0 | — | SCK2 | SCK1 | SCK0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | — | R/W | R/W | R/W |

System clock select 2 to 0

| | | | |
|---|---|---|----------------------------------|
| 0 | 0 | 0 | Bus master is in high-speed mode |
| | | 1 | Medium-speed clock = $\phi/2$ |
| 1 | 0 | 0 | Medium-speed clock = $\phi/4$ |
| | | 1 | Medium-speed clock = $\phi/8$ |
| 1 | 1 | 0 | Medium-speed clock = $\phi/16$ |
| | | 1 | Medium-speed clock = $\phi/32$ |
| | 1 | — | — |

Standby timer select 2 to 0

| | | | |
|---|---|---|------------------------------|
| 0 | 0 | 0 | Standby time = 8192 states |
| | | 1 | Standby time = 16384 states |
| | 1 | 0 | Standby time = 32768 states |
| | | 1 | Standby time = 65536 states |
| 1 | 0 | 0 | Standby time = 131072 states |
| | | 1 | Standby time = 262144 states |
| | 1 | 0 | Reserved |
| | | 1 | Standby time = 16 states* |

Note: * This setting must not be used in the flash memory version.

Software standby

| | |
|---|---|
| 0 | Transition to sleep mode after execution of SLEEP instruction in high-speed mode or medium-speed mode Transition to subsleep mode on execution of SLEEP instruction in subactive mode |
| 1 | Transition to software standby mode, subactive mode, or watch mode after execution of SLEEP instruction in high-speed mode or medium-speed mode Transition to watch mode or high-speed mode after execution of SLEEP instruction in subactive mode |

LPWRCCR—Low-Power Control Register

H'FF85

System

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|---|---|---|---|
| | DTON | LSON | NESEL | EXCLE | — | — | — | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | — | — | — | — |

Subclock input enable

| | |
|---|--|
| 0 | Subclock input from EXCL pin is disabled |
| 1 | Subclock input from EXCL pin is enabled |

Noise elimination sampling frequency select

| | |
|---|----------------------------------|
| 0 | Sampling at ϕ divided by 32 |
| 1 | Sampling at ϕ divided by 4 |

Low-speed on flag

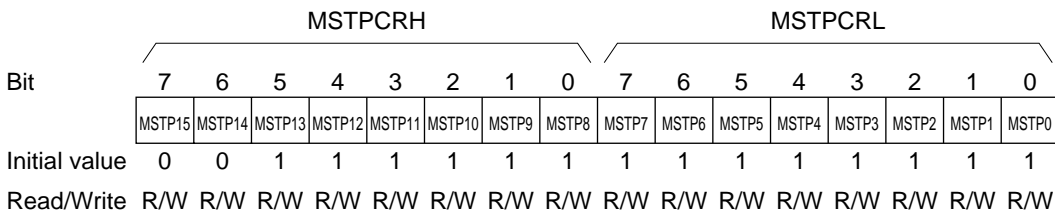
| | |
|---|---|
| 0 | <ul style="list-style-type: none"> When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, software standby mode, or watch mode* When a SLEEP instruction is executed in subactive mode, a transition is made to watch mode, or directly to high-speed mode After watch mode is cleared, a transition is made to high-speed mode |
| 1 | <ul style="list-style-type: none"> When a SLEEP instruction is executed in high-speed mode a transition is made to watch mode or subactive mode* When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode or watch mode After watch mode is cleared, a transition is made to subactive mode |

Note: * When a transition is made to watch mode or subactive mode, high-speed mode must be set.

Direct-transfer on flag

| | |
|---|--|
| 0 | <ul style="list-style-type: none"> When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, software standby mode, or watch mode* When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode or watch mode |
| 1 | <ul style="list-style-type: none"> When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made directly to subactive mode*, or a transition is made to sleep mode or software standby mode When a SLEEP instruction is executed in subactive mode, a transition is made directly to high-speed mode, or a transition is made to subsleep mode |

Note: * When a transition is made to watch mode or subactive mode, high-speed mode must be set.

MSTPCRH—Module Stop Control Register H**H'FF86****System****MSTPCRL—Module Stop Control Register L****H'FF87****System**

Module stop

| | |
|---|-----------------------------|
| 0 | Module stop mode is cleared |
| 1 | Module stop mode is set |

The correspondence between MSTPCR bits and on-chip supporting modules is shown below.

| Register | Bit | Module |
|----------|---------|--|
| MSTPCRH | MSTP15 | — |
| | MSTP14* | Data transfer controller (DTC) |
| | MSTP13 | 16-bit free-running timer (FRT) |
| | MSTP12 | 8-bit timers (TMR0, TMR1) |
| | MSTP11 | 8-bit PWM timer (PWM), 14-bit PWM timer (PWMX) |
| | MSTP10 | D/A converter |
| | MSTP9 | A/D converter |
| | MSTP8 | 8-bit timers (TMRX, TMRY), timer connection |
| MSTPCRL | MSTP7 | Serial communication interface 0 (SCI0) |
| | MSTP6 | Serial communication interface 1 (SCI1) |
| | MSTP5 | Serial communication interface 2 (SCI2) |
| | MSTP4* | I ² C bus interface (IIC) channel 0 (option) |
| | MSTP3* | I ² C bus interface (IIC) channel 1 (option) |
| | MSTP2 | Host interface (HIF), keyboard matrix interrupt mask register (KMIMR), port 6 MOS pull-up control register (KMPCR) |
| | MSTP1* | — |
| | MSTP0* | — |

Note: Do not set bit 15 to 1.

Bits 1 and 0 can be read and written but do not affect operation.

* Must be set to 1 in the H8S/2134 Group.

SMR1—Serial Mode Register 1

H'FF88

SCI1

SMR2—Serial Mode Register 2

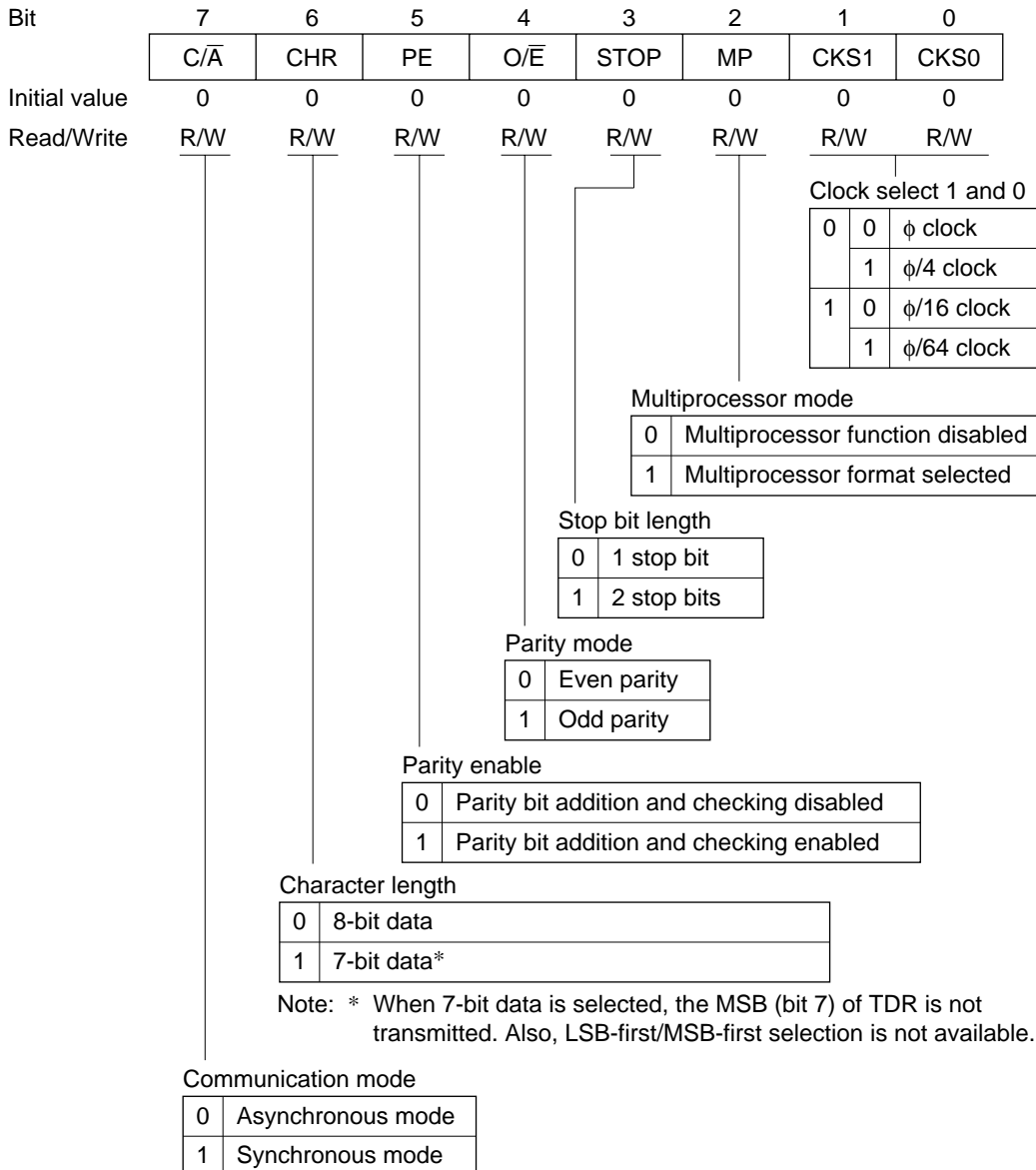
H'FFA0

SCI2

SMR0—Serial Mode Register 0

H'FFD8

SCI0



ICCR1—I²C Bus Control Register 1

H'FF88

IC1

ICCR0—I²C Bus Control Register 0

H'FFD8

IC0

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|------|-----|-----|------|------|--------|-----|
| | ICE | IEIC | MST | TRS | ACKE | BBSY | IRIC | SCP |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/(W)* | W |

| | |
|---|---------------------|
| I ² C bus interface interrupt enable | |
| 0 | Interrupts disabled |
| 1 | Interrupts enabled |

| | |
|---------------------------------------|---|
| I ² C bus interface enable | |
| 0 | I ² C bus interface module disabled, with SCL and SDA signal pins set to port function Internal state initialization of I ² C bus interface module SAR and SARX can be accessed |
| 1 | I ² C bus interface module enabled for transfer operations (pins SCL and SCA are driving the bus) ICMR and ICDR can be accessed |

| | |
|---|---|
| Start condition/stop condition prohibit | |
| 0 | Writing 0 issues a start or stop condition, in combination with the BBSY flag |
| 1 | Reading always returns a value of 1; writing is ignored |

| | |
|---|---|
| I ² C bus interface interrupt request flag | |
| 0 | Waiting for transfer, or transfer in progress |
| 1 | Interrupt requested |

Note: For the clearing and setting conditions, see section 16.2.5, I²C Bus Control Register (ICCR).

| | |
|----------|--|
| Bus busy | |
| 0 | Bus is free [Clearing condition] When a stop condition is detected |
| 1 | Bus is busy [Setting condition] When a start condition is detected |

| | |
|-------------------------------------|---|
| Acknowledge bit judgement selection | |
| 0 | The value of the acknowledge bit is ignored, and continuous transfer is performed |
| 1 | If the acknowledge bit is 1, continuous transfer is interrupted |

| | | |
|--|---|----------------------|
| Master/slave select (MST), transmit/receive select (TRS) | | |
| 0 | 0 | Slave receive mode |
| | 1 | Slave transmit mode |
| 1 | 0 | Master receive mode |
| | 1 | Master transmit mode |

Note: * Only 0 can be written, to clear the flag.

Note: For details, see section 16.2.5, I²C Bus Control Register (ICCR).

ICSR1—I²C Bus Status Register 1

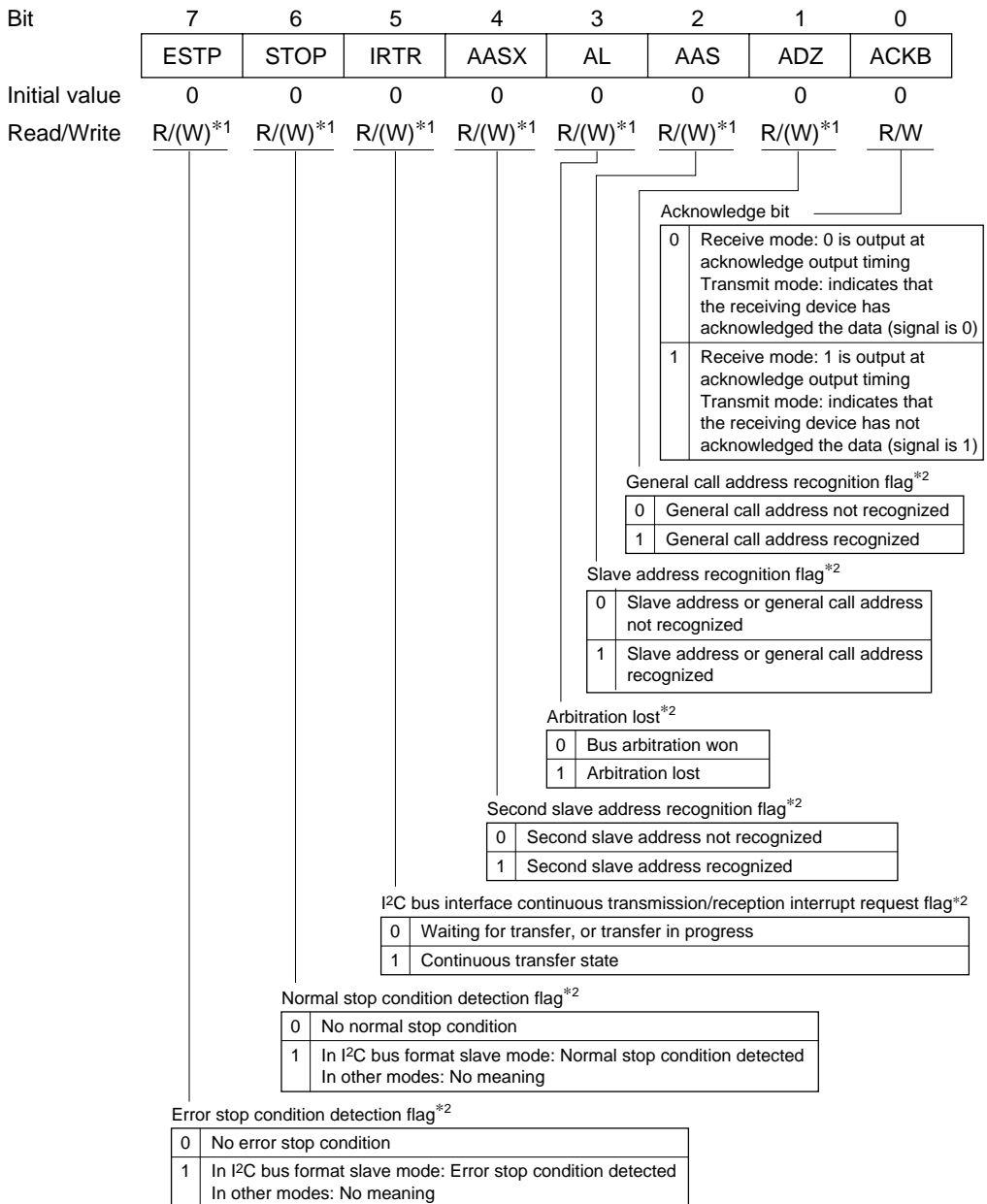
H'FF89

IIC1

ICSR0—I²C Bus Status Register 0

H'FFD9

IIC0



Notes: 1. Only 0 can be written, to clear the flag.

2. For the clearing and setting conditions, see section 16.2.6, I²C Bus Status Register (ICSR).

SCR1—Serial Control Register 1

H'FF8A

SCI1

SCR2—Serial Control Register 2

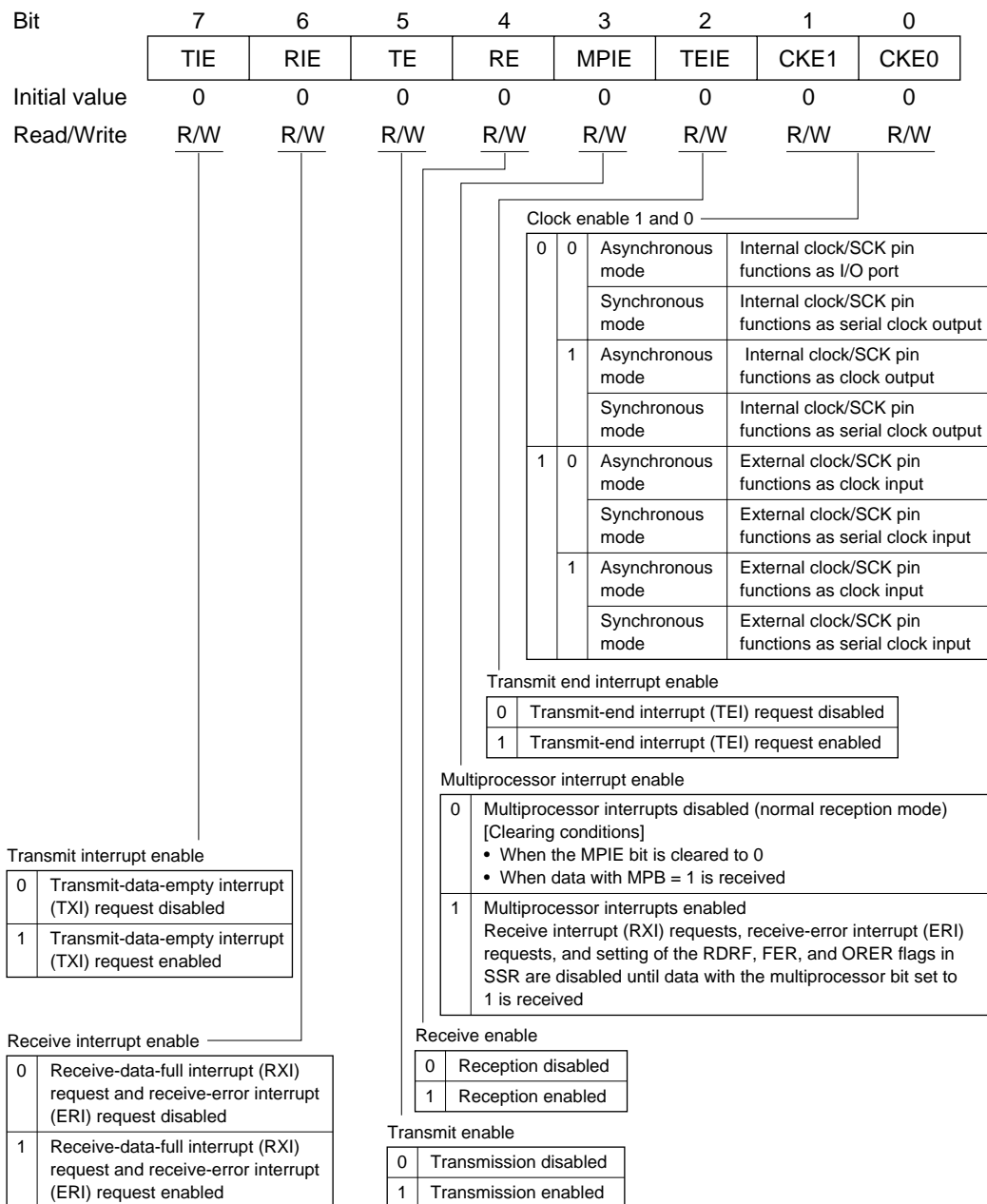
H'FFA2

SCI2

SCR0—Serial Control Register 0

H'FFDA

SCI0



| | | |
|-------------------------------------|---------------|-------------|
| RDR1—Receive Data Register 1 | H'FF8D | SCI1 |
| RDR2—Receive Data Register 2 | H'FFA5 | SCI2 |
| RDR0—Receive Data Register 0 | H'FFDD | SCI0 |

| | | | | | | | | |
|---------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

Stores serial receive data

| | | |
|--------------------------------------|---------------|-------------|
| TDR1—Transmit Data Register 1 | H'FF8B | SCI1 |
| TDR2—Transmit Data Register 2 | H'FFA3 | SCI2 |
| TDR0—Transmit Data Register 0 | H'FFDB | SCI0 |

| | | | | | | | | |
|---------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Stores serial transmit data

SSR1—Serial Status Register 1 **H'FF8C** **SCI1**
 SSR2—Serial Status Register 2 **H'FFA4** **SCI2**
 SSR0—Serial Status Register 0 **H'FFDC** **SCI0**

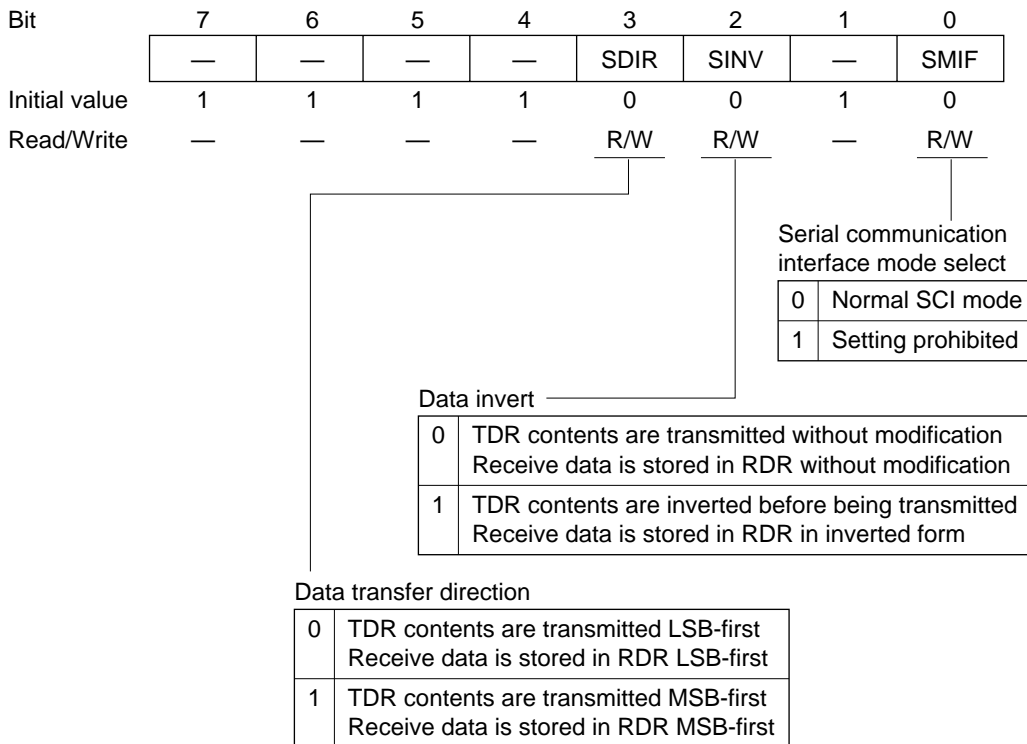
| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|------|-----|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT |
| Initial value | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R | R | R/W |

| | | | | | | | | |
|---|--|--|--|--|--|--|--|--|
| Multiprocessor bit transfer 0 Data with a 0 multi-processor bit is transmitted 1 Data with a 1 multi-processor bit is transmitted Multiprocessor bit 0 [Clearing condition] When data with a 0 multiprocessor bit is received 1 [Setting condition] When data with a 1 multiprocessor bit is received Transmit end 0 [Clearing conditions] • When 0 is written in TDRE after reading TDRE = 1 • When the DTC is activated by a TXI interrupt and writes data to TDR 1 [Setting conditions] • When the TE bit in SCR is 0 • When TDRE = 1 at transmission of the last bit of a 1-byte serial transmit character Parity error 0 [Clearing condition] When 0 is written in PER after reading PER = 1 1 [Setting condition] When, in reception, the number of 1 bits in the receive data plus the parity bit does not match the parity setting (even or odd) specified by the O/E bit in SMR Framing error 0 [Clearing condition] When 0 is written in FER after reading FER = 1 1 [Setting condition] When the SCI checks the stop bit at the end of the receive data when reception ends, and the stop bit is 0 Overrun error 0 [Clearing condition] When 0 is written in ORER after reading ORER = 1 1 [Setting condition] When the next serial reception is completed while RDRF = 1 Receive data register full 0 [Clearing conditions] • When 0 is written in RDRF after reading RDRF = 1 • When the DTC is activated by an RXI interrupt and reads data from RDR 1 [Setting condition] When serial reception ends normally and receive data is transferred from RSR to RDR Transmit data register empty 0 [Clearing conditions] • When 0 is written in TDRE after reading TDRE = 1 • When the DTC is activated by a TXI interrupt and writes data to TDR 1 [Setting conditions] • When the TE bit in SCR is 0 • When data is transferred from TDR to TSR and data can be written in TDR | | | | | | | | |
|---|--|--|--|--|--|--|--|--|

Note: * Only 0 can be written, to clear the flag.



| | | |
|---|---------------|-------------|
| SCMR1—Serial Interface Mode Register 1 | H'FF8E | SCI1 |
| SCMR2—Serial Interface Mode Register 2 | H'FFA6 | SCI2 |
| SCMR0—Serial Interface Mode Register 0 | H'FFDE | SCI0 |



ICDR1—I²C Bus Data Register 1**H'FF8E****IIC1****ICDR0—I²C Bus Data Register 0****H'FFDE****IIC0**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | ICDR7 | ICDR6 | ICDR5 | ICDR4 | ICDR3 | ICDR2 | ICDR1 | ICDR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

ICDRR

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | ICDRR7 | ICDRR6 | ICDRR5 | ICDRR4 | ICDRR3 | ICDRR2 | ICDRR1 | ICDRR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | R | R | R | R | R | R | R | R |

ICDRS

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | ICDRS7 | ICDRS6 | ICDRS5 | ICDRS4 | ICDRS3 | ICDRS2 | ICDRS1 | ICDRS0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | — | — | — | — | — | — | — | — |

ICDRT

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | ICDRT7 | ICDRT6 | ICDRT5 | ICDRT4 | ICDRT3 | ICDRT2 | ICDRT1 | ICDRT0 |
| Initial value | — | — | — | — | — | — | — | — |
| Read/Write | W | W | W | W | W | W | W | W |

TDRE, RDRF (internal flags)

| Bit | — | — |
|---------------|------|------|
| | TDRE | RDRF |
| Initial value | 0 | 0 |
| Read/Write | — | — |

Note: For details, see section 16.2.1, I²C Bus Data Register (ICDR).

| | | |
|--|---------------|-------------|
| SARX1—Second Slave Address Register 1 | H'FF8E | IIC1 |
| SAR1—Slave Address Register 1 | H'FF8F | IIC1 |
| SARX0—Second Slave Address Register 0 | H'FFDE | IIC0 |
| SAR0—Slave Address Register 0 | H'FFDF | IIC0 |

SAR

| | | | | | | | | |
|---------------|---------------|------|------|------|------|------|---------------|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SVA6 | SVA5 | SVA4 | SVA3 | SVA2 | SVA1 | SVA0 | FS |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| | Slave address | | | | | | Format select | |

SARX

| | | | | | | | | |
|---------------|----------------------|-------|-------|-------|-------|-------|-------|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SVAX6 | SVAX5 | SVAX4 | SVAX3 | SVAX2 | SVAX1 | SVAX0 | FSX |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | | | | | |
| | Second slave address | | | | | | | |

Format select

| DDCSWR Bit 6 | SAR Bit 0 | SARX Bit 0 | Operating Mode |
|-----------------|--------------|---------------|---|
| SW | FS | FSX | |
| 0 | 0 | 0 | I ² C bus format • SAR and SARX slave addresses recognized |
| | | 1 | I ² C bus format • SAR slave address recognized • SARX slave address ignored |
| | 1 | 0 | I ² C bus format • SAR slave address ignored • SARX slave address recognized |
| | | 1 | Synchronous serial format • SAR and SARX slave addresses ignored |
| 1 | 0 | 0 | Formatless mode (start/stop conditions not detected) • Acknowledge bit used |
| | | 1 | |
| | 1 | 0 | Formatless mode* (start/stop conditions not detected) • No acknowledge bit |

Note: * Do not set this mode when automatic switching to the I²C bus format is performed by means of the DDCSWR setting.

ICMR1—I²C Bus Mode Register 1

H'FF8F

IIC1

ICMR0—I²C Bus Mode Register 0

H'FFDF

IIC0

| | | | | | | | | |
|---------------|-----|------|------|------|------|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | MLS | WAIT | CKS2 | CKS1 | CKS0 | BC2 | BC1 | BC0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Bit counter

| BC2 | BC1 | BC0 | Synchronous serial format | I ² C bus format |
|-----|-----|-----|---------------------------|-----------------------------|
| 0 | 0 | 0 | 8 | 9 |
| | | 1 | 1 | 2 |
| | 1 | 0 | 2 | 3 |
| 1 | 0 | 1 | 3 | 4 |
| | | 0 | 4 | 5 |
| | 1 | 5 | 6 | |
| | 1 | 0 | 6 | 7 |
| | | 1 | 7 | 8 |

Serial clock select

| IICX | CKS2 | CKS1 | CKS0 | Clock |
|------|------|------|------|------------|
| 0 | 0 | 0 | 0 | $\phi/28$ |
| | | | 1 | $\phi/40$ |
| | | 1 | 0 | $\phi/48$ |
| | | | 1 | $\phi/64$ |
| | 1 | 0 | 0 | $\phi/80$ |
| | | | 1 | $\phi/100$ |
| | | 1 | 0 | $\phi/112$ |
| | | | 1 | $\phi/128$ |
| 1 | 0 | 0 | 0 | $\phi/56$ |
| | | | 1 | $\phi/80$ |
| | | 1 | 0 | $\phi/96$ |
| | | | 1 | $\phi/128$ |
| | 1 | 0 | 0 | $\phi/160$ |
| | | | 1 | $\phi/200$ |
| | | 1 | 0 | $\phi/224$ |
| | | | 1 | $\phi/256$ |

Wait insertion bit

| | |
|---|---|
| 0 | Data and acknowledge bits transferred consecutively |
| 1 | Wait inserted between data and acknowledge bits |

MSB-first/LSB-first select*

| | |
|---|-----------|
| 0 | MSB-first |
| 1 | LSB-first |

Note: * Do not set this bit to 1 when the I²C bus format is used.

TIER—Timer Interrupt Enable Register**H'FF90****FRT**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|------|---|
| | ICIAE | ICIBE | ICICE | ICIDE | OCIAE | OCIBE | OVIE | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | — |

| | |
|---------------------------------|---|
| Timer overflow interrupt enable | |
| 0 | Timer overflow interrupt request (FOVI) is disabled |
| 1 | Timer overflow interrupt request (FOVI) is enabled |

| | |
|-----------------------------------|---|
| Output compare interrupt B enable | |
| 0 | Output compare interrupt request B (OCIB) is disabled |
| 1 | Output compare interrupt request B (OCIB) is enabled |

| | |
|-----------------------------------|---|
| Output compare interrupt A enable | |
| 0 | Output compare interrupt request A (OCIA) is disabled |
| 1 | Output compare interrupt request A (OCIA) is enabled |

| | |
|----------------------------------|--|
| Input capture interrupt D enable | |
| 0 | Input capture interrupt request D (ICID) is disabled |
| 1 | Input capture interrupt request D (ICID) is enabled |

| | |
|----------------------------------|--|
| Input capture interrupt C enable | |
| 0 | Input capture interrupt request C (ICIC) is disabled |
| 1 | Input capture interrupt request C (ICIC) is enabled |

| | |
|----------------------------------|--|
| Input capture interrupt B enable | |
| 0 | Input capture interrupt request B (ICIB) is disabled |
| 1 | Input capture interrupt request B (ICIB) is enabled |

| | |
|----------------------------------|--|
| Input capture interrupt A enable | |
| 0 | Input capture interrupt request A (ICIA) is disabled |
| 1 | Input capture interrupt request A (ICIA) is enabled |

TCSR—Timer Control/Status Register

H'FF91

FRT

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|-------|
| | ICFA | ICFB | ICFC | ICFD | OCFA | OCFB | OVF | CCLRA |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/W |

| Counter clear A | |
|-----------------|-----------------------------------|
| 0 | FRC clearing is disabled |
| 1 | FRC is cleared at compare match A |

| Timer overflow flag | |
|---------------------|--|
| 0 | [Clearing condition] Read OVF when OVF = 1, then write 0 in OVF |
| 1 | [Setting condition] When FRC changes from H'FFFF to H'0000 |

| Output compare flag B | |
|-----------------------|---|
| 0 | [Clearing condition] Read OCFB when OCFB = 1, then write 0 in OCFB |
| 1 | [Setting condition] When FRC = OCRB |

| Output compare flag A | |
|-----------------------|---|
| 0 | [Clearing condition] Read OCFA when OCFA = 1, then write 0 in OCFA |
| 1 | [Setting condition] When FRC = OCRA |

| Input capture flag D | |
|----------------------|---|
| 0 | [Clearing condition] Read ICFD when ICFD = 1, then write 0 in ICFD |
| 1 | [Setting condition] When an input capture signal is received |

| Input capture flag C | |
|----------------------|---|
| 0 | [Clearing condition] Read ICFC when ICFC = 1, then write 0 in ICFC |
| 1 | [Setting condition] When an input capture signal is received |

| Input capture flag B | |
|----------------------|--|
| 0 | [Clearing condition] Read ICFB when ICFB = 1, then write 0 in ICFB |
| 1 | [Setting condition] When an input capture signal causes the FRC value to be transferred to ICRB |

| Input capture flag A | |
|----------------------|--|
| 0 | [Clearing condition] Read ICFA when ICFA = 1, then write 0 in ICFA |
| 1 | [Setting condition] When an input capture signal causes the FRC value to be transferred to ICRA |

Note: * Only 0 can be written in bits 7 to 1, to clear the flags.

FRC—Free-Running Counter**H'FF92****FRT**

| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Count value

OCRA/OCRB—Output Compare Register A/B**H'FF94****FRT**

| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Constantly compared with FRC value; OCF is set when OCR = FRC

TCR—Timer Control Register

H'FF96

FRT

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|------|------|
| | IEDGA | IEDGB | IEDGC | IEDGD | BUFEA | BUFEB | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

| | | |
|---|---|-------------------------------------|
| 0 | 0 | $\phi/2$ internal clock source |
| | 1 | $\phi/8$ internal clock source |
| 1 | 0 | $\phi/32$ internal clock source |
| | 1 | External clock source (rising edge) |

| | |
|---|---|
| 0 | ICRD is not used as a buffer register for input capture B |
| 1 | ICRD is used as a buffer register for input capture B |

| | |
|---|---|
| 0 | ICRC is not used as a buffer register for input capture A |
| 1 | ICRC is used as a buffer register for input capture A |

| | |
|---|-------------------------------------|
| 0 | Capture on the falling edge of FTID |
| 1 | Capture on the rising edge of FTID |

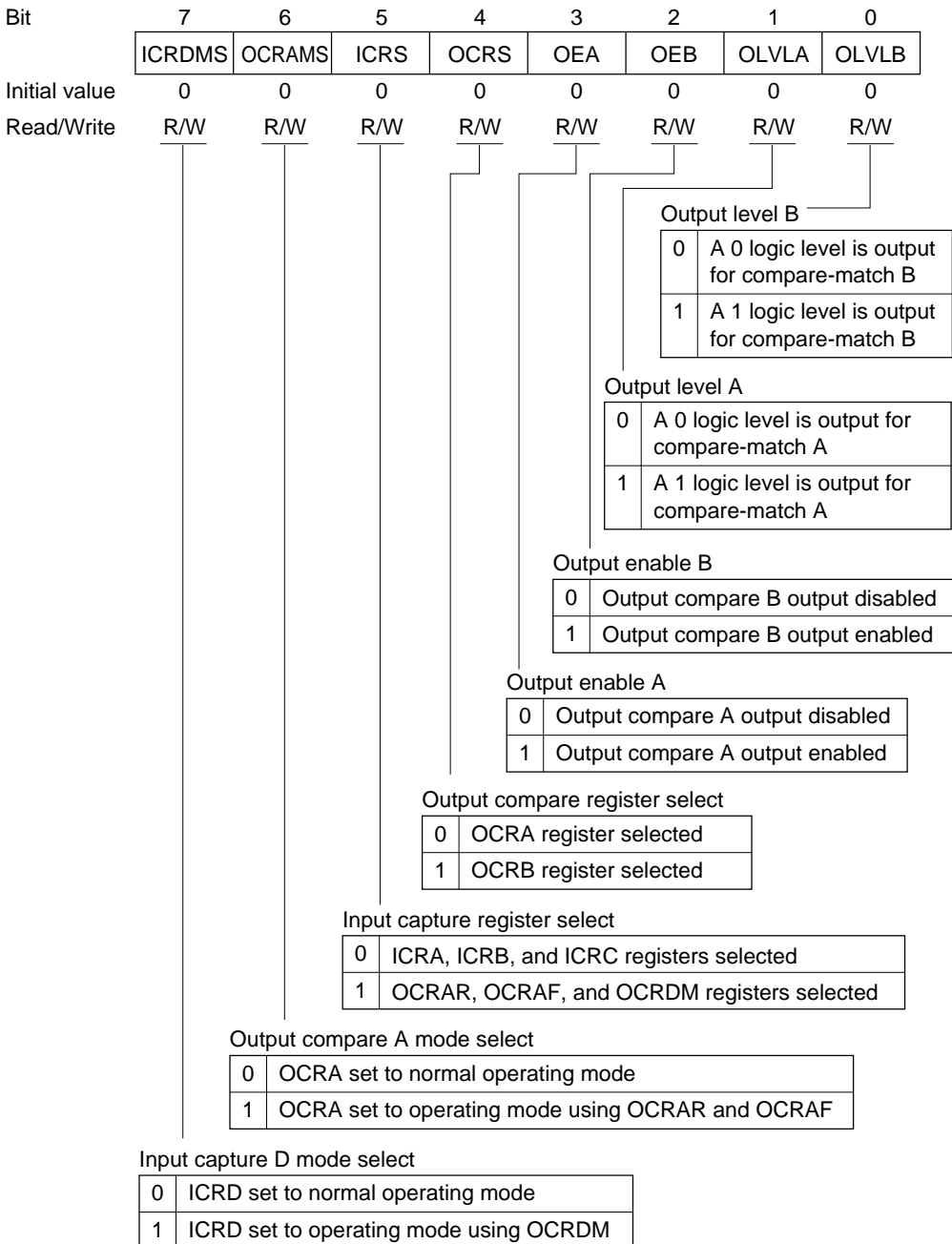
| | |
|---|-------------------------------------|
| 0 | Capture on the falling edge of FTIC |
| 1 | Capture on the rising edge of FTIC |

| | |
|---|-------------------------------------|
| 0 | Capture on the falling edge of FTIB |
| 1 | Capture on the rising edge of FTIB |

| | |
|---|-------------------------------------|
| 0 | Capture on the falling edge of FTIA |
| 1 | Capture on the rising edge of FTIA |

TOCR—Timer Output Compare Control Register H'FF97

FRT



OCRAR—Output Compare Register AR **H'FF98** **FRT**

OCRAF—Output Compare Register AF **H'FF9A** **FRT**

| | | | | | | | | | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Used for OCRA operation when OCRAMS = 1 in TOCR
(For details, see section 11.2.4, Output Compare Registers
AR and AF (OCRAR, OCRAF).)

OCRDM—Output Compare Register DM **H'FF9C** **FRT**

| | | | | | | | | | | | | | | | | |
|---------------|----|----|----|----|----|----|---|---|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Used for ICRD operation when ICRDMS = 1 in TOCR
(For details, see section 11.2.5, Output Compare Register
DM (OCRDM).)

ICRA—Input Capture Register A **H'FF98** **FRT**

ICRB—Input Capture Register B **H'FF9A** **FRT**

ICRC—Input Capture Register C **H'FF9C** **FRT**

ICRD—Input Capture Register D **H'FF9E** **FRT**

| | | | | | | | | | | | | | | | | |
|---------------|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R |

Stores FRC value when input capture signal is input
(ICRC and ICRD can be used for buffer operation.
For details, see section 11.2.3, Input Capture Registers
A to D (ICRA to ICRD).)

| | | |
|--|---------------|-------------|
| DADRAH—PWM (D/A) Data Register AH | H'FFA0 | PWMX |
| DADRAL—PWM (D/A) Data Register AL | H'FFA1 | PWMX |
| DADRBH—PWM (D/A) Data Register BH | H'FFA6 | PWMX |
| DADRBL—PWM (D/A) Data Register BL | H'FFA7 | PWMX |

| | | | | | | | | | | | | | | | | | |
|---------------|-----------|------|------|------|-----|-----|-----|-----|-----------|-----|-----|-----|-----|-----|-----|------|--|
| | ← DADRH → | | | | | | | | ← DADRL → | | | | | | | | |
| Bit (CPU) | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| Bit (data) | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | — | — | |
| DADRA | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | — | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | — | |
| DADRB | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | REGS | |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |

Register select (DADRB only)

| | |
|---|---------------------------------|
| 0 | DADRA and DADRB can be accessed |
| 1 | DACR and DACNT can be accessed |

Carrier frequency select

| | |
|---|--|
| 0 | Base cycle = resolution (T) × 64 DADR range is H'0401 to H'FFFD |
| 1 | Base cycle = resolution (T) × 256 DADR range is H'0103 to H'FFFF |

D/A conversion data

DACR—PWM (D/A) Control Register

H'FFA0

PWMX

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|---|---|-----|-----|-----|-----|
| | TEST | PWME | — | — | OEB | OEA | OS | CKS |
| Initial value | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | — | — | R/W | R/W | R/W | R/W |

Test mode

| | |
|---|--|
| 0 | User mode: the PWM D/A module operates normally |
| 1 | Test mode: correct conversion results will not be obtained |

Clock select

| | |
|---|--|
| 0 | Resolution (T) = system clock cycle time (t_{cyc}) |
| 1 | Resolution (T) = system clock cycle time (t_{cyc}) × 2 |

Output select

| | |
|---|---------------------|
| 0 | Direct PWM output |
| 1 | Inverted PWM output |

Output enable A

| | |
|---|---|
| 0 | PWM channel A output (PWX0 output pin) disabled |
| 1 | PWM channel A output (PWX0 output pin) enabled |

Output enable B

| | |
|---|---|
| 0 | PWM channel B output (PWX1 output pin) disabled |
| 1 | PWM channel B output (PWX1 output pin) enabled |

PWM enable

| | |
|---|---------------------------------------|
| 0 | DACNT operates as a 14-bit up-counter |
| 1 | DACNT halts at H'0003 |

DACNTH—PWM (D/A) Counter H

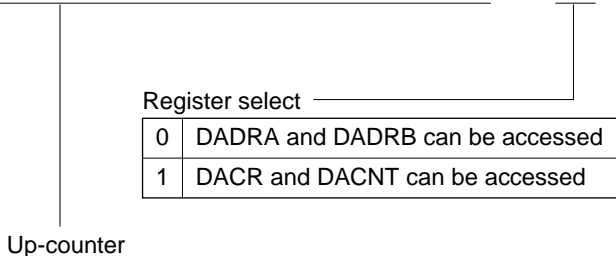
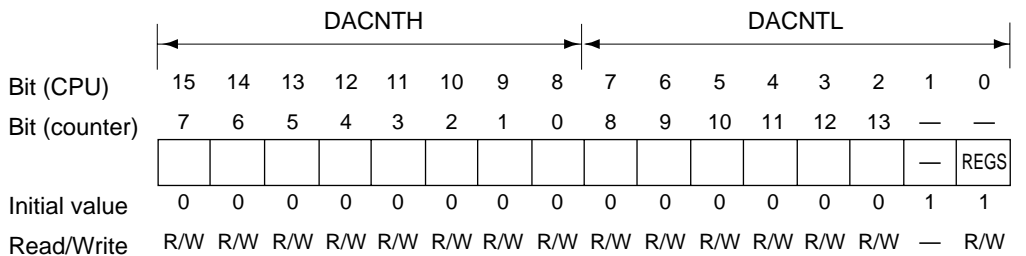
H'FFA6

PWMX

DACNTL—PWM (D/A) Counter L

H'FFA7

PWMX



TCSR0—Timer Control/Status Register 0

H'FFA8

WDT0

TCSR0

Bit

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|-------|-----|------|---------|------|------|------|
| Bit | OVF | WT/IT | TME | RSTS | RST/NMI | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Clock select 2 to 0

| CKS2 | CKS1 | CKS0 | Clock |
|------|------|------|---------------|
| 0 | 0 | 0 | $\phi/2$ |
| | | 1 | $\phi/64$ |
| | 1 | 0 | $\phi/128$ |
| | | 1 | $\phi/512$ |
| 1 | 0 | 0 | $\phi/2048$ |
| | | 1 | $\phi/8192$ |
| | 1 | 0 | $\phi/32768$ |
| | | 1 | $\phi/131072$ |

Reset or NMI

| | |
|---|--------------------------|
| 0 | NMI interrupt requested |
| 1 | Internal reset requested |

Reserved bit

Timer enable

| | |
|---|--|
| 0 | TCNT is initialized to H'00 and halted |
| 1 | TCNT counts |

Timer mode select

| | |
|---|--|
| 0 | Interval timer: Sends the CPU an interval timer interrupt request (WOVI) when TCNT overflows |
| 1 | Watchdog timer: Generates a reset or NMI interrupt when TCNT overflows |

Overflow flag

| | |
|---|--|
| 0 | [Clearing conditions] <ul style="list-style-type: none"> Write 0 in the TME bit Read TCSR when OVF = 1, then write 0 in OVFA |
| 1 | [Setting condition] When TCNT overflows (changes from H'FF to H'00) (When internal reset request generation is selected in watchdog timer mode, OVF is cleared automatically by the internal reset.) |

Note: * Only 0 can be written, to clear the flag.

TCNT0—Timer Counter 0**H'FFA8 (W), H'FFA9 (R)****WDT0****TCNT1—Timer Counter 1****H'FFEA (W), H'FFEB (R)****WDT1**

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Up-counter

PIPCR—Port 1 MOS Pull-Up Control Register**H'FFAC****Port 1**

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | P17PCR | P16PCR | P15PCR | P14PCR | P13PCR | P12PCR | P11PCR | P10PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Control of port 1 built-in MOS input pull-ups

P2PCR—Port 2 MOS Pull-Up Control Register**H'FFAD****Port 2**

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | P27PCR | P26PCR | P25PCR | P24PCR | P23PCR | P22PCR | P21PCR | P20PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Control of port 2 built-in MOS input pull-ups

P3PCR—Port 3 MOS Pull-Up Control Register**H'FFAE****Port 3**

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | P37PCR | P36PCR | P35PCR | P34PCR | P33PCR | P32PCR | P31PCR | P30PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Control of port 3 built-in MOS input pull-ups

P1DDR—Port 1 Data Direction Register**H'FFB0****Port 1**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P17DDR | P16DDR | P15DDR | P14DDR | P13DDR | P12DDR | P11DDR | P10DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

Specification of input or output for port 1 pins

P2DDR—Port 2 Data Direction Register**H'FFB1****Port 2**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P27DDR | P26DDR | P25DDR | P24DDR | P23DDR | P22DDR | P21DDR | P20DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

Specification of input or output for port 2 pins

P1DR—Port 1 Data Register**H'FFB2****Port 1**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P17DR | P16DR | P15DR | P14DR | P13DR | P12DR | P11DR | P10DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Output data for port 1 pins

P2DR—Port 2 Data Register**H'FFB3****Port 2**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P27DR | P26DR | P25DR | P24DR | P23DR | P22DR | P21DR | P20DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Output data for port 2 pins

P3DDR—Port 3 Data Direction Register**H'FFB4****Port 3**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P37DDR | P36DDR | P35DDR | P34DDR | P33DDR | P32DDR | P31DDR | P30DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

|
Specification of input or output for port 3 pins

P4DDR—Port 4 Data Direction Register**H'FFB5****Port 4**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P47DDR | P46DDR | P45DDR | P44DDR | P43DDR | P42DDR | P41DDR | P40DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

|
Specification of input or output for port 4 pins

P3DR—Port 3 Data Register**H'FFB6****Port 3**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P37DR | P36DR | P35DR | P34DR | P33DR | P32DR | P31DR | P30DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Output data for port 3 pins

P4DR—Port 4 Data Register**H'FFB7****Port 4**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P47DR | P46DR | P45DR | P44DR | P43DR | P42DR | P41DR | P40DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Output data for port 4 pins

P5DDR—Port 5 Data Direction Register**H'FFB8****Port 5**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|--------|--------|--------|
| | — | — | — | — | — | P52DDR | P51DDR | P50DDR |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | W | W | W |

Specification of input or output for port 5 pins

P6DDR—Port 6 Data Direction Register**H'FFB9****Port 6**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P67DDR | P66DDR | P65DDR | P64DDR | P63DDR | P62DDR | P61DDR | P60DDR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

Specification of input or output for port 6 pins

P5DR—Port 5 Data Register**H'FFBA****Port 5**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|-------|-------|-------|
| | — | — | — | — | — | P52DR | P51DR | P50DR |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Read/Write | — | — | — | — | — | R/W | R/W | R/W |

Output data for port 5 pins

P6DR—Port 6 Data Register**H'FFBB****Port 6**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P67DR | P66DR | P65DR | P64DR | P63DR | P62DR | P61DR | P60DR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Output data for port 6 pins

P8DDR—Port 8 Data Direction Register**H'FFBD****Port 8**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|--------|--------|--------|--------|--------|--------|--------|
| | — | P86DDR | P85DDR | P84DDR | P83DDR | P82DDR | P81DDR | P80DDR |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | W | W | W | W | W | W | W |

|
Specification of input or output for port 8 pins

P7PIN—Port 7 Input Data Register**H'FFBE****Port 7**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P77PIN | P76PIN | P75PIN | P74PIN | P73PIN | P72PIN | P71PIN | P70PIN |
| Initial value | —* | —* | —* | —* | —* | —* | —* | —* |
| Read/Write | R | R | R | R | R | R | R | R |

|
Port 7 pin states

Note: * Determined by state of pins P77 to P70.

P8DR—Port 8 Data Register**H'FFBF****Port 8**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|-------|-------|-------|-------|-------|-------|-------|
| | — | P86DR | P85DR | P84DR | P83DR | P82DR | P81DR | P80DR |
| Initial value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | — | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

|
Output data for port 8 pins

P9DDR—Port 9 Data Direction Register **H'FFC0** **Port 9**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | P97DDR | P96DDR | P95DDR | P94DDR | P93DDR | P92DDR | P91DDR | P90DDR |
| Mode 1 | | | | | | | | |
| Initial value | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |
| Modes 2 and 3 | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | W | W | W | W | W | W | W | W |

Specification of input or output for port 9 pins

P9DR—Port 9 Data Register **H'FFC1** **Port 9**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | P97DR | P96DR | P95DR | P94DR | P93DR | P92DR | P91DR | P90DR |
| Initial value | 0 | —* | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R | R/W | R/W | R/W | R/W | R/W | R/W |

Output data for port 9 pins

Note: * Determined by state of pin P96.

IER—IRQ Enable Register **H'FFC2** **Interrupt Controller**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| | IRQ7E | IRQ6E | IRQ5E | IRQ4E | IRQ3E | IRQ2E | IRQ1E | IRQ0E |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

IRQ7 to IRQ0 enable

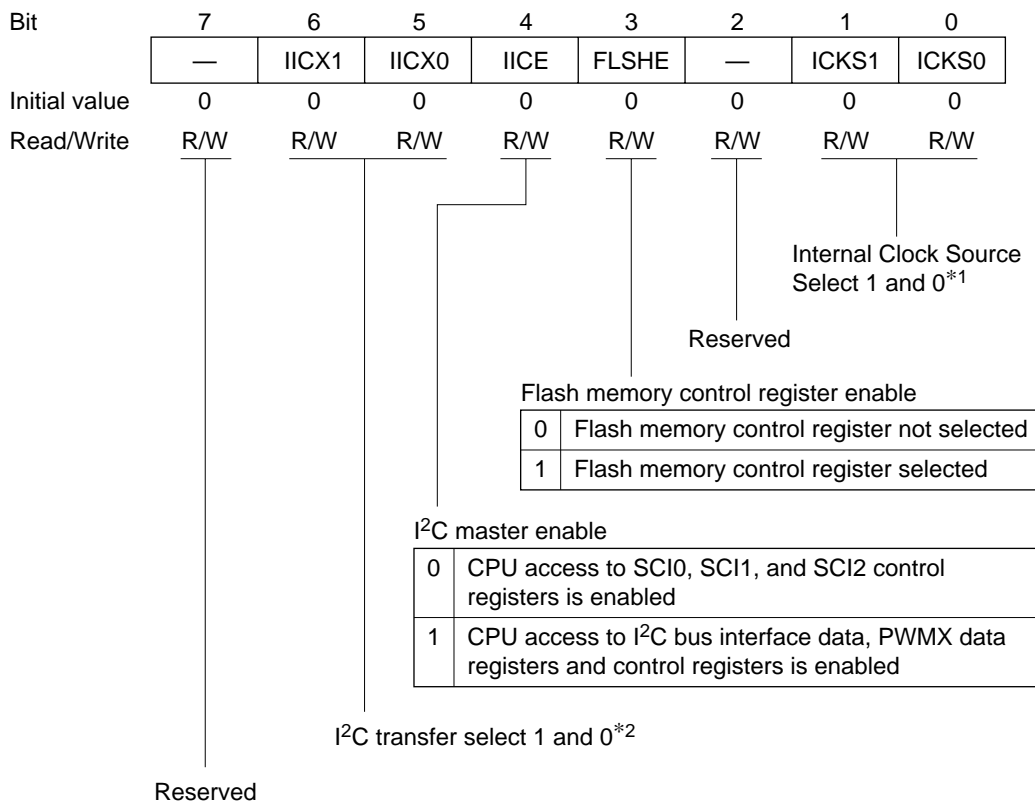
| | |
|---|-------------------------|
| 0 | IRQn interrupt disabled |
| 1 | IRQn interrupt enabled |

(n = 7 to 0)

STCR—Serial Timer Control Register

H'FFC3

System



- Notes: 1. Used for 8-bit timer input clock selection. For details, see section 12.2.4, Timer Control Register (TCR).
2. Used for I²C bus interface transfer clock selection. For details, see section 16.2.4, I²C Bus Mode Register (ICMR).

SYSCR—System Control Register

H'FFFC4

System

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-------|-------|------|-------|-----|------|
| | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME |
| Initial value | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| Read/Write | R/W | R/W | R | R/W | R | R/W | R/W | R/W |

| RAM Enable | |
|------------|-------------------------|
| 0 | On-chip RAM is disabled |
| 1 | On-chip RAM is enabled |

| Host interface enable | |
|-----------------------|---|
| 0 | Addresses H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF are used for access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers |
| 1 | Addresses H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF are used for access to host interface data registers and control registers, and keyboard controller and MOS input pull-up control registers |

| NMI edge select | |
|-----------------|--------------|
| 0 | Falling edge |
| 1 | Rising edge |

| External reset | |
|----------------|--|
| 0 | Reset generated by watchdog timer overflow |
| 1 | Reset generated by an external reset |

| Interrupt control selection mode 1 and 0 | | | |
|--|-------|------------------------|---|
| Bit 5 | Bit 4 | Interrupt control mode | Description |
| INTM1 | INTM0 | 0 | Interrupts controlled by 1 bit (Initial value) |
| | | 1 | Interrupts controlled by 1 and UI bits, and ICR |
| 1 | 0 | 2 | Cannot be used in the LSI |
| | 1 | 3 | Cannot be used in the LSI |

| IOS enable | |
|------------|---|
| 0 | The $\overline{AS}/\overline{IOS}$ pin functions as the address strobe pin (Low output when accessing an external area) |
| 1 | The $\overline{AS}/\overline{IOS}$ pin functions as the I/O strobe pin (Low output when accessing a specified address from H'(FF)F000 to H'(FF)FE4F)* |

Note: * In the H8S/2138 F-ZTAT A-mask version, the address range is from H'(FF)F000 to H'(FF)F7FF.

| CS2 enable | | |
|-------------|------------|---|
| SYSCR Bit 7 | HICR Bit 0 | Description |
| CS2E | FGA20E | |
| | | |
| 0 | 0 | $\overline{CS2}$ pin function halted (CS2 fixed high internally) |
| | 1 | |
| 1 | 0 | $\overline{CS2}$ pin function selected for P81/ $\overline{CS2}$ pin |
| | 1 | $\overline{CS2}$ pin function selected for P90/ $\overline{ECS2}$ pin |

MDCR—Mode Control Register**H'FFC5****System**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|----------------------|---|---------------------------|---|---|---|----------------|------|
| | EXPE | — | — | — | — | — | MDS1 | MDS0 |
| Initial value | —* | 0 | 0 | 0 | 0 | 0 | —* | —* |
| Read/Write | R/W* | — | — | — | — | — | R | R |
| | Expanded mode enable | | | | | | Mode pin state | |
| | 0 | | Single-chip mode selected | | | | | |
| | 1 | | Expanded mode selected | | | | | |

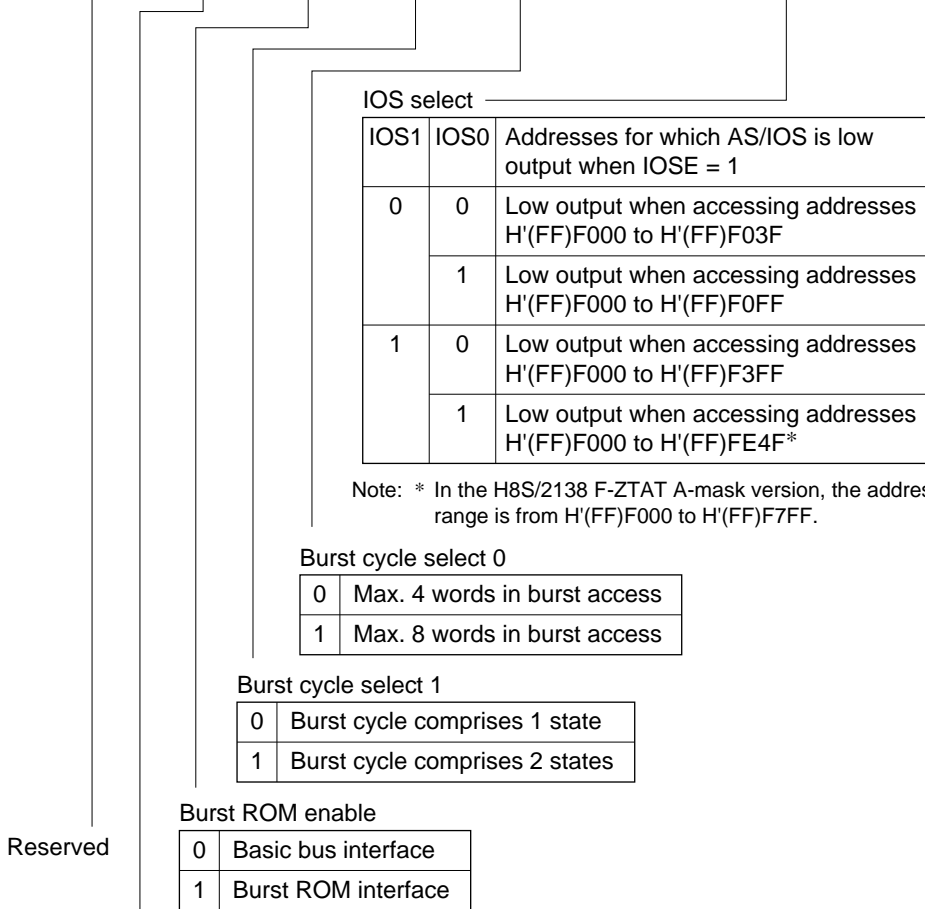
Note: * Determined by the MD1 and MD0 pins.

BCR—Bus Control Register

H'FFC6

Bus Controller

| | | | | | | | | |
|---------------|-------|-------|--------|--------|--------|-----|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ICIS1 | ICIS0 | BRSTRM | BRSTS1 | BRSTS0 | — | IOS1 | IOS0 |
| Initial value | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |



Idle cycle insert 0

| | |
|---|---|
| 0 | Idle cycle not inserted in case of successive external read and external write cycles |
| 1 | Idle cycle inserted in case of successive external read and external write cycles |

WSCR—Wait State Control Register

H'FFC7

Bus Controller

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|-----|-----|------|------|-----|-----|
| | RAMS | RAM0 | ABW | AST | WMS1 | WMS0 | WC1 | WC0 |
| Initial value | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Reserved

Note: Always write 0 when writing to these bits in the A-mask version.

Wait count 1 and 0

| | | |
|---|---|--|
| 0 | 0 | No program wait states are inserted |
| | 1 | 1 program wait state is inserted in external memory space accesses |
| 1 | 0 | 2 program wait states are inserted in external memory space accesses |
| | 1 | 3 program wait states are inserted in external memory space accesses |

Wait mode select 1 and 0

| | | |
|---|---|--------------------|
| 0 | 0 | Program wait mode |
| | 1 | Wait disabled mode |
| 1 | 0 | Pin wait mode |
| | 1 | Pin auto-wait mode |

Access state control

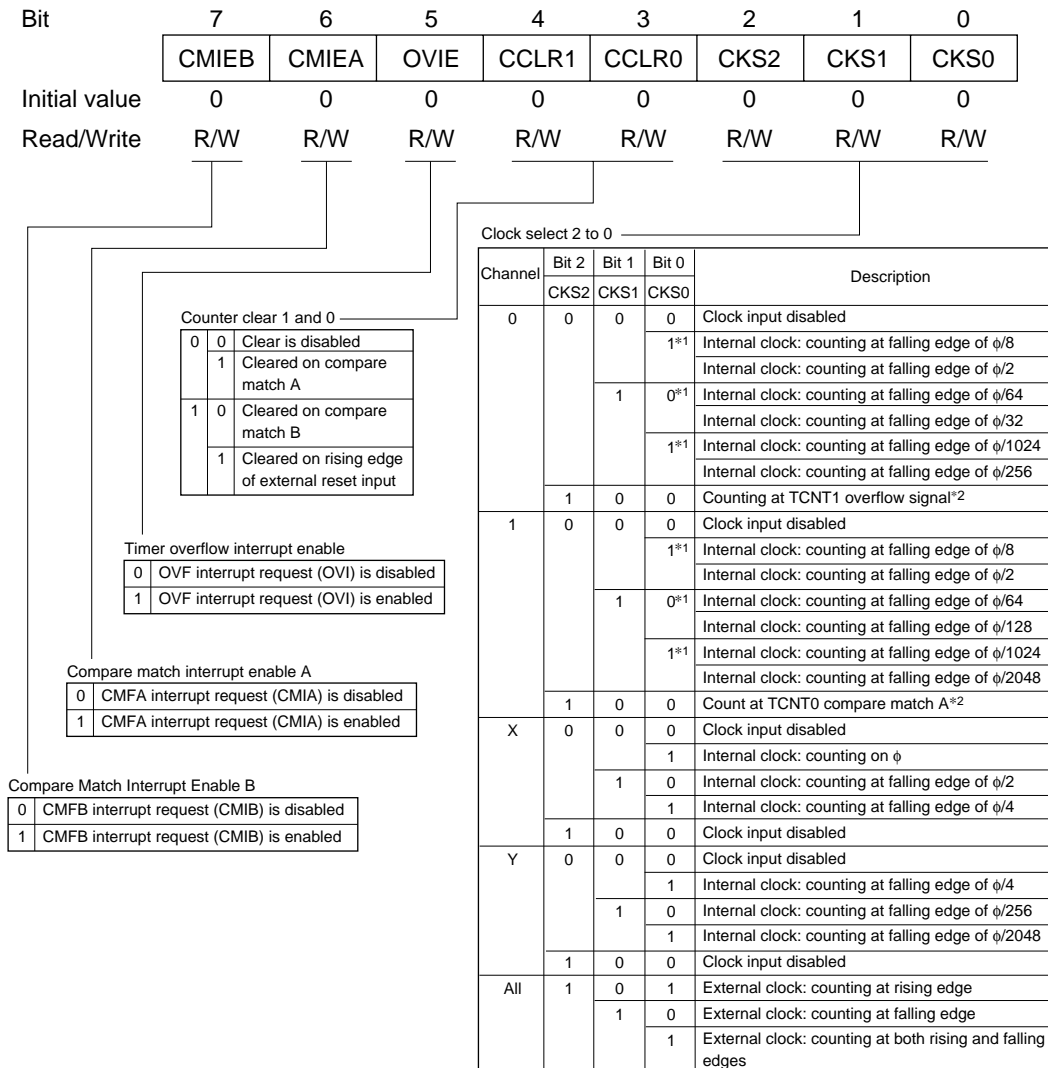
| | |
|---|---|
| 0 | External memory space is designated as 2-state access space Wait state insertion in external memory space accesses is disabled |
| 1 | External memory space is designated as 3-state access space Wait state insertion in external memory space accesses is enabled |

Bus width control

| | |
|---|--|
| 0 | External memory space designated as 16-bit access space (illegal setting in the H8S/2138 and H8S/2134) |
| 1 | External memory space designated as 8-bit access space |

TCR0—Timer Control Register 0
TCR1—Timer Control Register 1
TCRX—Timer Control Register X
TCRY—Timer Control Register Y

H'FFC8 **TMR0**
H'FFC9 **TMR1**
H'FFF0 **TMRX**
H'FFF0 **TMR Y**



- Notes: 1. Selected by ICKS1 and ICKS0 in STCR. For details, see section 12.2.4, Timer Control Register (TCR).
2. If the clock input of channel 0 is the TCNT1 overflow signal and that of channel 1 is the TCNT0 compare match signal, no incrementing clock is generated. Do not use this setting.

TCSR0—Timer Control/Status Register 0

H'FFCA

TMR0

TCSR0

Bit

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|-----|-----|-----|-----|-----|
| CMFB | CMFA | OVF | ADTE | OS3 | OS2 | OS1 | OS0 | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/W | R/W | R/W | R/W | R/W |

Output select 1 and 0

| | | |
|---|---|--|
| 0 | 0 | No change at compare match A |
| | 1 | 0 output at compare match A |
| 1 | 0 | 1 output at compare match A |
| | 1 | Output inverted at compare match A (toggle output) |

Output select 3 and 2

| | | |
|---|---|--|
| 0 | 0 | No change at compare match B |
| | 1 | 0 output at compare match B |
| 1 | 0 | 1 output at compare match B |
| | 1 | Output inverted at compare match B (toggle output) |

A/D trigger enable

| | |
|---|--|
| 0 | A/D converter start requests by compare match A are disabled |
| 1 | A/D converter start requests by compare match A are enabled |

Timer overflow flag

| | |
|---|--|
| 0 | [Clearing condition] Read OVF when OVF = 1, then write 0 in OVF |
| 1 | [Setting condition] When TCNT overflows from H'FF to H'00 |

Compare match flag A

| | |
|---|--|
| 0 | [Clearing conditions] <ul style="list-style-type: none"> Read CMFA when CMFA = 1, then write 0 in CMFA When the DTC is activated by a CMIA interrupt |
| 1 | [Setting condition] When TCNT = TCORA |

Compare match flag B

| | |
|---|--|
| 0 | [Clearing conditions] <ul style="list-style-type: none"> Read CMFB when CMFB = 1, then write 0 in CMFB When the DTC is activated by a CMIB interrupt |
| 1 | [Setting condition] When TCNT = TCORB |

Note: * Only 0 can be written in bits 7 to 5, to clear the flags.

TCSR1—Timer Control/Status Register 1

H'FFCB

TMR1

TCSR1

Bit

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|---|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | — | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | — | R/W | R/W | R/W | R/W |

Output select 1 and 0

| | | |
|---|---|--|
| 0 | 0 | No change at compare match A |
| | 1 | 0 output at compare match A |
| 1 | 0 | 1 output at compare match A |
| | 1 | Output inverted at compare match A (toggle output) |

Output select 3 and 2

| | | |
|---|---|--|
| 0 | 0 | No change at compare match B |
| | 1 | 0 output at compare match B |
| 1 | 0 | 1 output at compare match B |
| | 1 | Output inverted at compare match B (toggle output) |

Timer overflow flag

| | |
|---|--|
| 0 | [Clearing condition] Read OVF when OVF = 1, then write 0 in OVF |
| 1 | [Setting condition] When TCNT overflows from H'FF to H'00 |

Compare match flag A

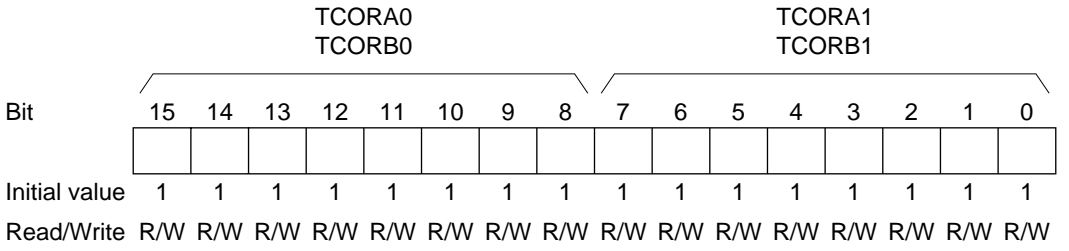
| | |
|---|---|
| 0 | [Clearing conditions] • Read CMFA when CMFA = 1, then write 0 in CMFA • When the DTC is activated by a CMIA interrupt |
| 1 | [Setting condition] When TCNT = TCORA |

Compare match flag B

| | |
|---|---|
| 0 | [Clearing conditions] • Read CMFB when CMFB = 1, then write 0 in CMFB • When the DTC is activated by a CMIB interrupt |
| 1 | [Setting condition] When TCNT = TCORB |

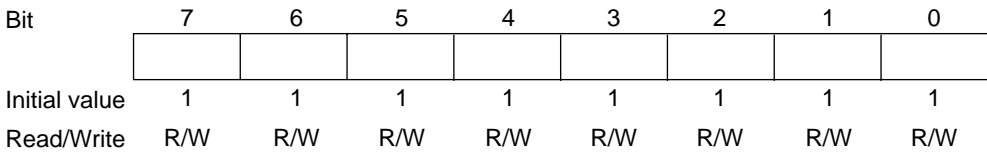
Note: * Only 0 can be written in bits 7 to 5, to clear the flags.

| | | |
|---|---------------|--------------|
| TCORA0—Time Constant Register A0 | H'FFCC | TMR0 |
| TCORA1—Time Constant Register A1 | H'FFCD | TMR1 |
| TCORB0—Time Constant Register B0 | H'FFCE | TMR0 |
| TCORB1—Time Constant Register B1 | H'FFCF | TMR1 |
| TCORAY—Time Constant Register AY | H'FFF2 | TMR Y |
| TCORBY—Time Constant Register BY | H'FFF3 | TMR Y |
| TCORC—Time Constant Register C | H'FFF5 | TMR X |
| TCORAX—Time Constant Register AX | H'FFF6 | TMR X |
| TCORBX—Time Constant Register BX | H'FFF7 | TMR X |



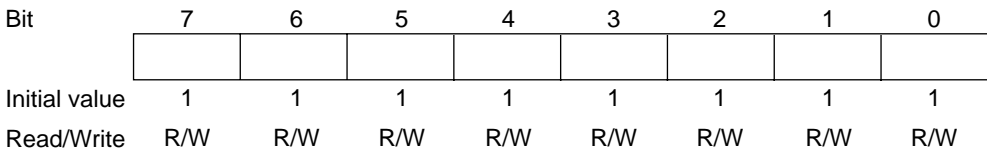
Compare match flag (CMF) is set when TCOR and TCNT values match

TCORAX, TCORAY
TCORBX, TCORBY



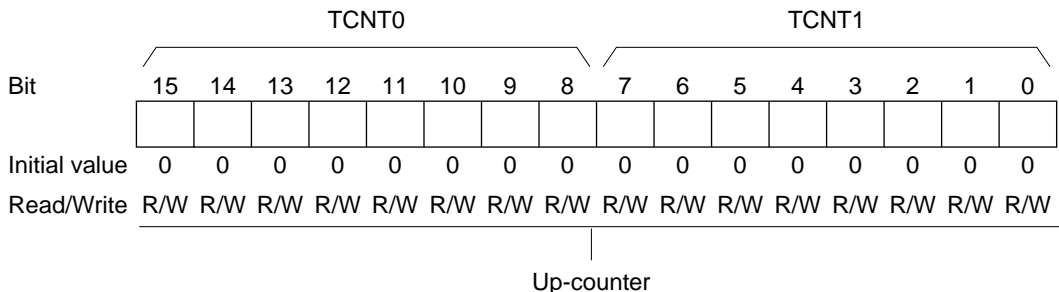
Compare match flag (CMF) is set when TCOR and TCNT values match

TCORC

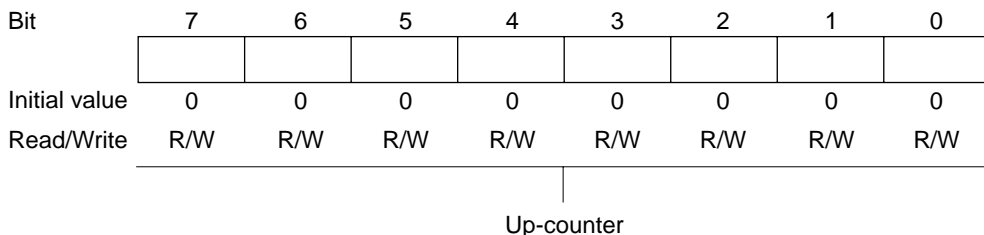


Compare match C signal is generated when sum of TCORC and TICR contents match TCNT value

| | | |
|------------------------------|---------------|-------------|
| TCNT0—Timer Counter 0 | H'FFD0 | TMR0 |
| TCNT1—Timer Counter 1 | H'FFD1 | TMR1 |
| TCNTX—Timer Counter X | H'FFF4 | TMRX |
| TCNTY—Timer Counter Y | H'FFF4 | TMRX |



TCNTX, TCNTY



| | | |
|--|---------------|------------|
| PWOERA—PWM Output Enable Register A | H'FFD3 | PWM |
| PWOERB—PWM Output Enable Register B | H'FFD2 | PWM |

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PWOERA | OE7 | OE6 | OE5 | OE4 | OE3 | OE2 | OE1 | OE0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

| | | | | | | | | |
|---------------|------|------|------|------|------|------|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PWOERB | OE15 | OE14 | OE13 | OE12 | OE11 | OE10 | OE9 | OE8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Switching between PWM output and port output

| DDR | OE | Description |
|-----|----|-----------------------------------|
| 0 | 0 | Port input |
| | 1 | Port input |
| 1 | 0 | Port output or PWM 256/256 output |
| | 1 | PWM output (0 to 255/256 output) |

| | | |
|--|---------------|------------|
| PWDPRA—PWM Data Polarity Register A | H'FFD5 | PWM |
| PWDPRB—PWM Data Polarity Register B | H'FFD4 | PWM |

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PWDPRA | OS7 | OS6 | OS5 | OS4 | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

| | | | | | | | | |
|---------------|------|------|------|------|------|------|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PWDPRB | OS15 | OS14 | OS13 | OS12 | OS11 | OS10 | OS9 | OS8 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

PWM output polarity control

| | |
|---|---|
| 0 | PWM direct output (PWDR value corresponds to high width of output) |
| 1 | PWM inverted output (PWDR value corresponds to low width of output) |

PWSL—PWM Register Select

H'FFD6

PWM

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|---|---|-----|-----|-----|-----|
| | PWCKE | PWCKS | — | — | RS3 | RS2 | RS1 | RS0 |
| Initial value | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | — | — | R/W | R/W | R/W | R/W |

Register Select

| | | | | | |
|---|---|---|---|-----------------|-----------------|
| 0 | 0 | 0 | 0 | PWDR0 selected | |
| | | 1 | 0 | PWDR1 selected | |
| | | 1 | 1 | PWDR2 selected | |
| | | 1 | 1 | PWDR3 selected | |
| 1 | 0 | 0 | 0 | PWDR4 selected | |
| | | 1 | 0 | PWDR5 selected | |
| | | 1 | 1 | PWDR6 selected | |
| | | 1 | 1 | PWDR7 selected | |
| 1 | 0 | 0 | 0 | PWDR8 selected | |
| | | 1 | 0 | PWDR9 selected | |
| | | 1 | 1 | PWDR10 selected | |
| | | 1 | 1 | PWDR11 selected | |
| | 1 | 0 | 0 | 0 | PWDR12 selected |
| | | | 1 | 0 | PWDR13 selected |
| | | | 1 | 1 | PWDR14 selected |
| | | | 1 | 1 | PWDR15 selected |

PWM clock enable, PWM clock select

| PWSL | | PCSR | | Description |
|-------|-------|-------------------|-------|--------------------------------|
| Bit 7 | Bit 6 | Bit 2 | Bit 1 | |
| PWCKE | PWCKS | PWCKB | PWCKA | |
| 0 | — | — | — | Clock input disabled |
| 1 | 0 | — | — | ϕ (system clock) selected |
| | | | | 1 |
| | 1 | $\phi/4$ selected | | |
| | 1 | 1 | 0 | $\phi/8$ selected |
| | | | | 1 |

PWDR0 to PWDR15—PWM Data Registers

H'FFD7

PWM

| | | | | | | | | |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Specifies duty factor of basic output pulse and number of additional pulses

ADDRAH—A/D Data Register AH

H'FFE0

A/D Converter

ADDRAL—A/D Data Register AL

H'FFE1

A/D Converter

ADDRBH—A/D Data Register BH

H'FFE2

A/D Converter

ADDRBL—A/D Data Register BL

H'FFE3

A/D Converter

ADDRCH—A/D Data Register CH

H'FFE4

A/D Converter

ADDRCL—A/D Data Register CL

H'FFE5

A/D Converter

ADDRDH—A/D Data Register DH

H'FFE6

A/D Converter

ADDRDL—A/D Data Register DL

H'FFE7

A/D Converter

| | | | | | | | | | | | | | | | | |
|---------------|-------|-----|-----|-----|-----|-----|-----|-----|-------|-----|---|---|---|---|---|---|
| | ADDRH | | | | | | | | ADDRL | | | | | | | |
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | AD1 | AD0 | — | — | — | — | — | — |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R | R |

Stores A/D data

Correspondence between analog input channels and ADDR registers

| Analog Input Channel | | A/D Data Register |
|----------------------|------------------|-------------------|
| Group 0 | Group 1 | |
| AN0 | AN4 | ADDRA |
| AN1 | AN5 | ADDRB |
| AN2 | AN6 or CIN0–CIN7 | ADDRC |
| AN3 | AN7 | ADDRD |

ADCSR—A/D Control/Status Register

H'FFE8

A/D Converter

| | | | | | | | | |
|---------------|--------|------|------|------|-----|-----|-----|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ADF | ADIE | ADST | SCAN | CKS | CH2 | CH1 | CH0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Channel select

| Group selection | Channel selection | | | Description | |
|-----------------|-------------------|-----|------------------|---------------------------------|-----------|
| CH2 | CH1 | CH0 | Single mode | | Scan mode |
| 0 | 0 | 0 | AN0 | AN0 | |
| | | 1 | AN1 | AN0, AN1 | |
| | 1 | 0 | AN2 | AN0, AN1, AN2 | |
| | | 1 | AN3 | AN0, AN1, AN2, AN3 | |
| 1 | 0 | 0 | AN4 | AN4 | |
| | | 1 | AN5 | AN4, AN5 | |
| | 1 | 0 | AN6 or CIN0–CIN7 | AN4, AN5, AN6 or CIN0–CIN7 | |
| | | 1 | AN7 | AN4, AN5, AN6 or CIN0–CIN7, AN7 | |

Clock select

| | |
|---|-------------------------------------|
| 0 | Conversion time = 266 states (max.) |
| 1 | Conversion time = 134 states (max.) |

Scan mode

| | |
|---|-------------|
| 0 | Single mode |
| 1 | Scan mode |

A/D start

| | |
|---|---|
| 0 | A/D conversion stopped |
| 1 | <ul style="list-style-type: none"> Single mode: A/D conversion is started. Cleared to 0 automatically when conversion on the specified channel ends Scan mode: A/D conversion is started. Conversion continues sequentially on the selected channels until ADST is cleared to 0 by software, a reset, or a transition to standby mode or module stop mode |

A/D interrupt enable

| | |
|---|---|
| 0 | A/D conversion end interrupt (ADI) request disabled |
| 1 | A/D conversion end interrupt (ADI) request enabled |

A/D end flag

| | |
|---|--|
| 0 | <p>[Clearing conditions]</p> <ul style="list-style-type: none"> When 0 is written in the to ADF flag after reading ADF = 1 When the DTC is activated by an ADI interrupt, and ADDR is read |
| 1 | <p>[Setting conditions]</p> <ul style="list-style-type: none"> Single mode: When A/D conversion ends Scan mode: When A/D conversion ends on all specified channels |

Note: * Only 0 can be written, to clear the flag.

ADCR—A/D Control Register

H'FFE9

A/D Converter

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-------|-------|---|---|---|---|---|---|
| | TRGS1 | TRGS0 | — | — | — | — | — | — |
| Initial value | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | — | — | — | — | — | — |

Timer trigger select

| | | |
|---|---|--|
| 0 | 0 | Start of A/D conversion by external trigger is disabled |
| | 1 | Start of A/D conversion by external trigger is disabled |
| 1 | 0 | Start of A/D conversion by external trigger (8-bit timer) is enabled |
| | 1 | Start of A/D conversion by external trigger pin is enabled |

TCSR1—Timer Control/Status Register 1

H'FFEA

WDT1

TCSR1

Bit

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---------------------|---------------------|-----|-----|-----------------------|------|------|------|
| | OVF | WT/ \overline{IT} | TME | PSS | RST/ \overline{NMI} | CKS2 | CKS1 | CKS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W) ^{*1} | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Clock select 2 to 0

| PSS | CKS2 | CKS1 | CKS0 | Clock | |
|-----|------|------|------|----------------------|-------------|
| 0 | 0 | 0 | 0 | $\phi/2$ | |
| | | | 1 | $\phi/64$ | |
| | | 1 | 0 | 0 | $\phi/128$ |
| | | | | 1 | $\phi/512$ |
| | | | 1 | 0 | $\phi/2048$ |
| | | | | 1 | $\phi/8192$ |
| 1 | 0 | 0 | 0 | $\phi\text{SUB}/2$ | |
| | | | 1 | $\phi\text{SUB}/4$ | |
| | | 1 | 0 | $\phi\text{SUB}/8$ | |
| | | | 1 | $\phi\text{SUB}/16$ | |
| | 1 | 0 | 0 | $\phi\text{SUB}/32$ | |
| | | | 1 | $\phi\text{SUB}/64$ | |
| | | 1 | 0 | $\phi\text{SUB}/128$ | |
| | | | 1 | $\phi\text{SUB}/256$ | |

Reset or NMI

| | |
|---|--------------------------|
| 0 | NMI interrupt requested |
| 1 | Internal reset requested |

Prescaler select^{*2}

| | |
|---|---|
| 0 | TCNT counts on a ϕ -based prescaler (PSM) scaled clock |
| 1 | TCNT counts on a ϕSUB -based prescaler (PSS) scaled clock |

Timer enable

| | |
|---|--|
| 0 | TCNT is initialized to H'00 and halted |
| 1 | TCNT counts |

Timer mode select

| | |
|---|--|
| 0 | Interval timer mode: Interval timer interrupt request (WOVI) sent to CPU when TCNT overflows |
| 1 | Watchdog timer mode: Reset or NMI interrupt request sent to CPU when TCNT overflows |

Overflow flag

| | |
|---|---|
| 0 | [Clearing conditions] <ul style="list-style-type: none"> When 0 is written in the TME bit When 0 is written in OVF after reading TCSR when OVF = 1 |
| 1 | [Setting condition] When TCNT overflows from H'FF to H'00 When internal reset request is selected in watchdog timer mode, OVF is cleared automatically by an internal reset after being set |

Notes: 1. Only 0 can be written, to clear the flag.

2. For operation control when a transition is made to power-down mode, see section 24.2.3, Timer Control/Status Register (TCSR).

HICR—Host Interface Control Register**H'FFF0****HIF**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|--------|--------|--------|
| | — | — | — | — | — | IBFIE2 | IBFIE1 | FGA20E |
| Initial value | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| Slave R/W | — | — | — | — | — | R/W | R/W | R/W |
| Host R/W | — | — | — | — | — | — | — | — |

Fast gate A20 enable

| | |
|---|---------------------------------|
| 0 | Fast gate A20 function disabled |
| 1 | Fast gate A20 function enabled |

Input data register interrupt enable 1

| | |
|---|---|
| 0 | Input data register (IDR1) receive complete interrupt is disabled |
| 1 | Input data register (IDR1) receive complete interrupt is enabled |

Input data register full interrupt enable 2

| | |
|---|---|
| 0 | Input data register (IDR2) receive complete interrupt is disabled |
| 1 | Input data register (IDR2) receive complete interrupt is enabled |

TCSR_X—Timer Control/Status Register X

H'FFF1

TMR_XTCSR_X

Bit

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | ICF | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/(W)* | R/W | R/W | R/W | R/W |

Output select 1 and 0

| | | |
|---|---|--|
| 0 | 0 | No change at compare match A |
| | 1 | 0 output at compare match A |
| 1 | 0 | 1 output at compare match A |
| | 1 | Output inverted at compare match A (toggle output) |

Output select 3 and 2

| | | |
|---|---|--|
| 0 | 0 | No change at compare match B |
| | 1 | 0 output at compare match B |
| 1 | 0 | 1 output at compare match B |
| | 1 | Output inverted at compare match B (toggle output) |

Input capture flag

| | |
|---|--|
| 0 | [Clearing condition] Read ICF when ICF = 1, then write 1 in ICF |
| 1 | [Setting condition] When a rising edge followed by a falling edge is detected in the external reset signal after the ICST bit in TCONRI has been set to 1 |

Timer overflow flag

| | |
|---|--|
| 0 | [Clearing condition] When 0 is written in OVF after reading OVF = 1 |
| 1 | [Setting condition] When TCNT overflows from H'FF to H'00 |

Compare match flag A

| | |
|---|--|
| 0 | [Clearing conditions] • When 0 is written in CMFA after reading CMFA = 1 • When the DTC is activated by a CMIA interrupt |
| 1 | [Setting condition] When TCNT = TCORA |

Compare match flag B

| | |
|---|--|
| 0 | [Clearing conditions] • When 0 is written in CMFB after reading CMFB = 1 • When the DTC is activated by a CMIB interrupt |
| 1 | [Setting condition] When TCNT = TCORB |

Note: * Only 0 can be written in bits 7 to 4, to clear the flags.

TCSRY—Timer Control/Status Register Y

H'FFF1

TMR_Y

TCSRY

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|------|-----|-----|-----|-----|
| | CMFB | CMFA | OVF | ICIE | OS3 | OS2 | OS1 | OS0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/(W)* | R/(W)* | R/(W)* | R/W | R/W | R/W | R/W | R/W |

| | | |
|---|---|--|
| 0 | 0 | No change at compare match A |
| | 1 | 0 output at compare match A |
| 1 | 0 | 1 output at compare match A |
| | 1 | Output inverted at compare match A (toggle output) |

| | | |
|---|---|--|
| 0 | 0 | No change at compare match B |
| | 1 | 0 output at compare match B |
| 1 | 0 | 1 output at compare match B |
| | 1 | Output inverted at compare match B (toggle output) |

| | |
|---|---|
| 0 | Interrupt request by ICF (ICIX) is disabled |
| 1 | Interrupt request by ICF (ICIX) is enabled |

| | |
|---|--|
| 0 | [Clearing condition] When 0 is written in OVF after reading OVF = 1 |
| 1 | [Setting condition] When TCNT overflows from H'FF to H'00 |

| | |
|---|--|
| 0 | [Clearing conditions] • When 0 is written in CMFA after reading CMFA = 1 • When the DTC is activated by a CMIA interrupt |
| 1 | [Setting condition] When TCNT = TCORA |

| | |
|---|--|
| 0 | [Clearing conditions] • When 0 is written in CMFB after reading CMFB = 1 • When the DTC is activated by a CMIB interrupt |
| 1 | [Setting condition] When TCNT = TCORB |

Note: * Only 0 can be written in bits 7 to 5, to clear the flags.

KMIMR—Keyboard Matrix Interrupt Mask Register **H'FFF1** **Interrupt Controller**

KMIMR

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | KMIMR7 | KMIMR6 | KMIMR5 | KMIMR4 | KMIMR3 | KMIMR2 | KMIMR1 | KMIMR0 |
| Initial value | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Keyboard matrix interrupt mask

| | |
|---|--|
| 0 | Key-sense input interrupt requests enabled |
| 1 | Key-sense input interrupt requests disabled* |

Note: * However, the initial value of KMIMR6 is 0 because the KMIMR6 bit controls both $\overline{IRQ6}$ interrupt request masking and key-sense input enabling.

TICRR—Input Capture Register R **H'FFF2** **TMRX****TICRF—Input Capture Register F** **H'FFF3** **TMRX**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| | | | | | | | | |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R | R | R | R | R | R | R | R |

Stores TCNT value at fall of external trigger input

KMPCR—Port 6 MOS Pull-Up Control Register **H'FFF2** **Port 6**

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | KM7PCR | KM6PCR | KM5PCR | KM4PCR | KM3PCR | KM2PCR | KM1PCR | KM0PCR |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Control of port 6 built-in MOS input pull-ups

Note: KMPCR has the same address as TICRR/TCORAY of TMRX/TMRY.
When selecting KMPCR, set the HIE bit to 1 in SYSCR.

IDR1—Input Data Register 1**H'FFF4****HIF****IDR2—Input Data Register 2****H'FFFC****HIF**

| | | | | | | | | |
|---------------|------|------|------|------|------|------|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Slave R/W | R | R | R | R | R | R | R | R |
| Host R/W | W | W | W | W | W | W | W | W |

Stores host data bus contents at rise of \overline{IOW} when \overline{CS} is low

ODR1—Output Data Register 1**H'FFF5****HIF****ODR2—Output Data Register 2****H'FFFD****HIF**

| | | | | | | | | |
|---------------|------|------|------|------|------|------|------|------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 |
| Initial value | — | — | — | — | — | — | — | — |
| Slave R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Host R/W | R | R | R | R | R | R | R | R |

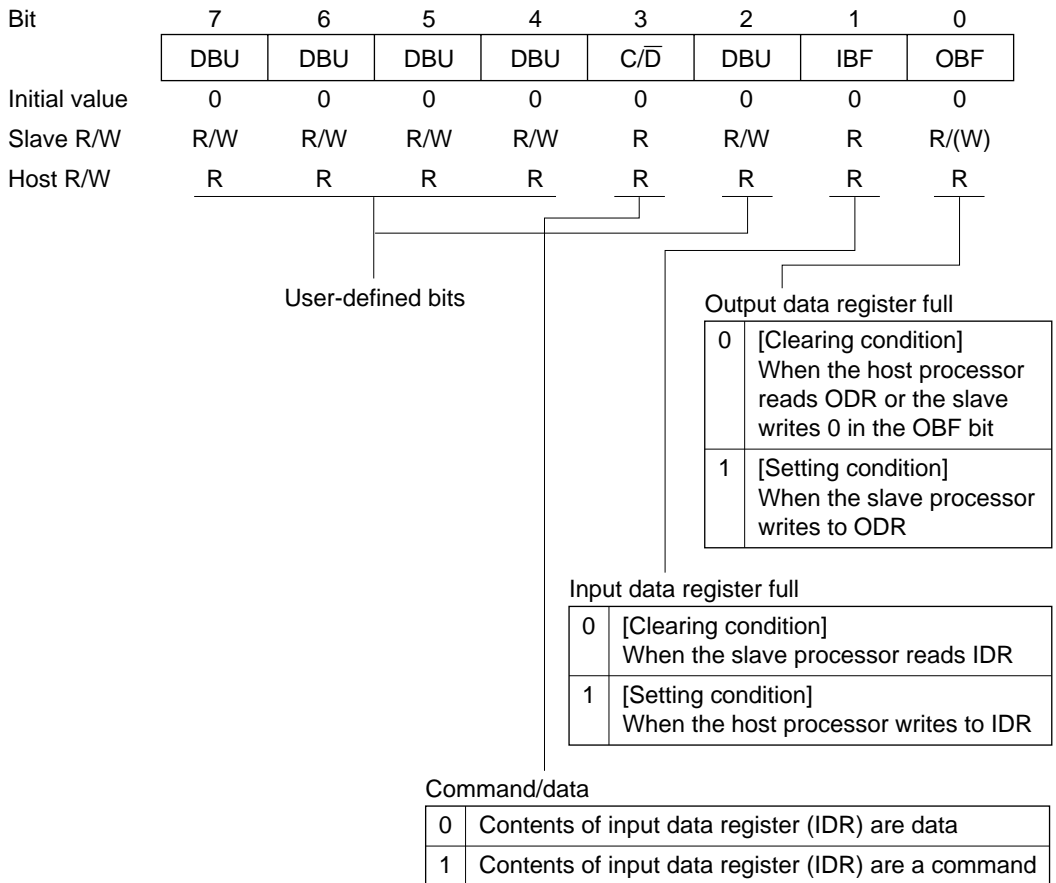
ODR contents are output to the host data bus when HA0 is low, \overline{CS} is low, and \overline{IOR} is low

TISR—Timer Input Select Register**H'FFF5****TMRY**

| | | | | | | | | |
|---------------|---|---|---|---|---|---|---|-----|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | — | — | — | — | — | — | — | IS |
| Initial value | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| Read/Write | — | — | — | — | — | — | — | R/W |

Input select

| | |
|---|--|
| 0 | IVG signal is selected (H8S/2138 Group) External clock/reset input is disabled (H8S/2134 Group) |
| 1 | VSYNCl/TMIY (TMCiY/TMRIY) is selected |

STR1—Status Register 1**H'FFF6****HIF****STR2—Status Register 2****H'FFFE****HIF****DADR0—D/A Data Register 0****H'FFF8****D/A Converter****DADR1—D/A Data Register 1****H'FFF9****D/A Converter**

DACR—D/A Control Register

H'FFFA

D/A Converter

| | | | | | | | | |
|---------------|-------|-------|-----|---|---|---|---|---|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | DAOE1 | DAOE0 | DAE | — | — | — | — | — |
| Initial value | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 |
| Read/Write | R/W | R/W | R/W | — | — | — | — | — |

D/A enabled

| DAOE1 | DAOE0 | DAE | Conversion result |
|-------|-------|--|---|
| 0 | 0 | * | Channel 0 and 1 D/A conversion disabled |
| | | 0 | Channel 0 D/A conversion enabled Channel 1 D/A conversion disabled |
| | 1 | Channel 0 and 1 D/A conversion enabled | |
| 1 | 0 | 0 | Channel 0 D/A conversion disabled Channel 1 D/A conversion enabled |
| | | 1 | Channel 0 and 1 D/A conversion enabled |
| | 1 | * | Channel 0 and 1 D/A conversion enabled |

*: Don't care

D/A output enable 0

| | |
|---|---|
| 0 | Analog output DA0 disabled |
| 1 | D/A conversion is enabled on channel 0. Analog output DA0 is enabled |

D/A output enable 1

| | |
|---|---|
| 0 | Analog output DA1 disabled |
| 1 | D/A conversion is enabled on channel 1. Analog output DA1 is enabled |

TCONRI—Timer Connection Register I

H'FFFC

Timer Connection

| | | | | | | | | |
|---------------|--------|--------|-------|------|-------|-------|-------|-------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SIMOD1 | SIMOD0 | SCONE | ICST | HFINV | VFINV | HIINV | VIINV |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Input synchronization signal inversion

| | |
|---|---|
| 0 | The VSYNCI pin state is used directly as the VSYNCI input |
| 1 | The VSYNCI pin state is inverted before use as the VSYNCI input |

Input synchronization signal inversion

| | |
|---|--|
| 0 | The HSYNCI and CSYNCI pin states are used directly as the HSYNCI and CSYNCI inputs |
| 1 | The HSYNCI and CSYNCI pin states are inverted before use as the HSYNCI and CSYNCI inputs |

Input synchronization signal inversion

| | |
|---|---|
| 0 | The VFBACKI pin state is used directly as the VFBACKI input |
| 1 | The VFBACKI pin state is inverted before use as the VFBACKI input |

Input synchronization signal inversion

| | |
|---|---|
| 0 | The HFBACKI pin state is used directly as the HFBACKI input |
| 1 | The HFBACKI pin state is inverted before use as the HFBACKI input |

Input capture start bit

| | |
|---|--|
| 0 | The TICRR and TICRF input capture functions are stopped [Clearing condition] When a rising edge followed by a falling edge is detected on TMR1X |
| 1 | The TICRR and TICRF input capture functions are operating (Waiting for detection of a rising edge followed by a falling edge on TMR1X) [Setting condition] When 1 is written in ICST after reading ICST = 0 |

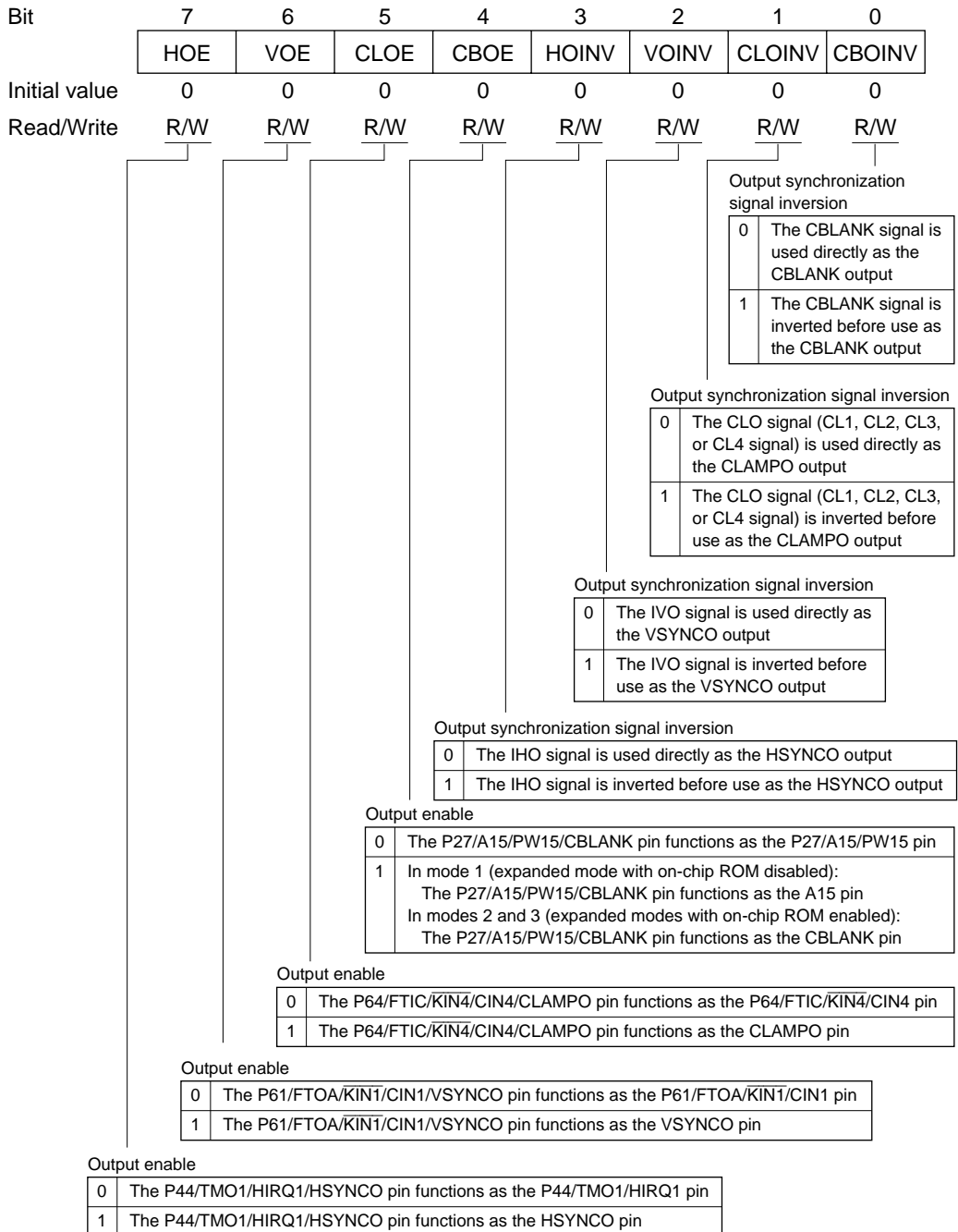
Synchronization signal connection enable

| SCONE | Mode | FTIA | FTIB | FTIC | FTID | TMC1 | TMR1 |
|-------|--|------------|-------------|---------------|------------|------------|--------------------|
| 0 | Normal connection | FTIA input | FTIB input | FTIC input | FTID input | TMC1 input | TMR1 input |
| 1 | Synchronization signal connection mode | IVI signal | TMO1 signal | VFBACKI input | IHI signal | IHI signal | IVI inverse signal |

Input synchronization mode select 1 and 0

| SIMOD1 | SIMOD0 | Mode | IHI signal | IVI signal |
|--------|--------|----------------|---------------|---------------|
| 0 | 0 | No signal | HFBACKI input | VFBACKI input |
| | 1 | S-on-G mode | CSYNCI input | PDC input |
| 1 | 0 | Composite mode | HSYNCI input | PDC input |
| | 1 | Separate mode | HSYNCI input | VSYNCI input |

TCONRO—Timer Connection Register O **H'FFFF** **Timer Connection**



TCONRS—Timer Connection Register S

H'FFFE

Timer Connection

| | | | | | | | | |
|---------------|--------|--------|--------|--------|--------|--------|--------|--------|
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | TMRX/Y | ISGENE | HOMOD1 | HOMOD0 | VOMOD1 | VOMOD0 | CLMOD1 | CLMOD0 |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

Clamp waveform mode select 1 and 0

| ISGENE | CLMOD1 | CLMOD0 | Description |
|--------|--------|--------|----------------------------|
| 0 | 0 | 0 | The CL1 signal is selected |
| | | 1 | The CL2 signal is selected |
| | 1 | 0 | The CL3 signal is selected |
| | | 1 | |
| 1 | 0 | 0 | The CL4 signal is selected |
| | | 1 | |
| | 1 | 0 | |
| | | 1 | |

Vertical synchronization output mode select 1 and 0

| ISGENE | VOMOD1 | VOMOD0 | Description |
|--------|--------|--------|--|
| 0 | 0 | 0 | The IVI signal (without fall modification or IHI synchronization) is selected |
| | | 1 | The IVI signal (without fall modification, with IHI synchronization) is selected |
| | 1 | 0 | The IVI signal (with fall modification, without IHI synchronization) is selected |
| | | 1 | The IVI signal (with fall modification and IHI synchronization) is selected |
| 1 | 0 | 0 | The IVG signal is selected |
| | | 1 | |
| | 1 | 0 | |
| | | 1 | |

Horizontal synchronization output mode select 1 and 0

| ISGENE | HOMOD1 | HOMOD0 | Description |
|--------|--------|--------|---|
| 0 | 0 | 0 | The IHI signal (without 2fH modification) is selected |
| | | 1 | The IHI signal (with 2fH modification) is selected |
| | 1 | 0 | The CLI signal is selected |
| | | 1 | |
| 1 | 0 | 0 | The IHG signal is selected |
| | | 1 | |
| | 1 | 0 | |
| | | 1 | |

Internal synchronization signal select

TMRX/TMRY access select

| | |
|---|---|
| 0 | The TMRX registers are accessed at addresses H'FFF0 to H'FFF5 |
| 1 | The TMRY registers are accessed at addresses H'FFF0 to H'FFF5 |

SEDGR—Edge Sense Register

H'FFFF

Timer Connection

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---------|---------|---------|---------|---------|---------|------|------|
| | VEDG | HEDG | CEDG | HFEDG | VFEDG | PREQF | IHI | IVI |
| Initial value | 0 | 0 | 0 | 0 | 0 | 0 | __*2 | __*2 |
| Read/Write | R/(W)*1 | R/(W)*1 | R/(W)*1 | R/(W)*1 | R/(W)*1 | R/(W)*1 | R | R |

| IVI signal level | |
|------------------|------------------------|
| 0 | The IVI signal is low |
| 1 | The IVI signal is high |

| IHI signal level | |
|------------------|------------------------|
| 0 | The IHI signal is low |
| 1 | The IHI signal is high |

| Pre-equalization flag | |
|-----------------------|--|
| 0 | [Clearing condition] When 0 is written in PREQF after reading PREQF = 1 |
| 1 | [Setting condition] When an IHI signal 2fH modification condition is detected |

| VFBACKI edge | |
|--------------|--|
| 0 | [Clearing condition] When 0 is written in VFEDG after reading VFEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the VFBACKI pin |

| HFBACKI edge | |
|--------------|--|
| 0 | [Clearing condition] When 0 is written in HFEDG after reading HFEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the HFBACKI pin |

| CSYNCI edge | |
|-------------|--|
| 0 | [Clearing condition] When 0 is written in CEDG after reading CEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the CSYNCI pin |

| HSYNCI edge | |
|-------------|--|
| 0 | [Clearing condition] When 0 is written in HEDG after reading HEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the HSYNCI pin |

| VSYNCI edge | |
|-------------|--|
| 0 | [Clearing condition] When 0 is written in VEDG after reading VEDG = 1 |
| 1 | [Setting condition] When a rising edge is detected on the VSYNCI pin |

- Notes: 1. Only 0 can be written, to clear the flags.
 2. The initial value is undefined since it depends on the pin states.

Appendix C I/O Port Block Diagrams

C.1 Port 1 Block Diagram

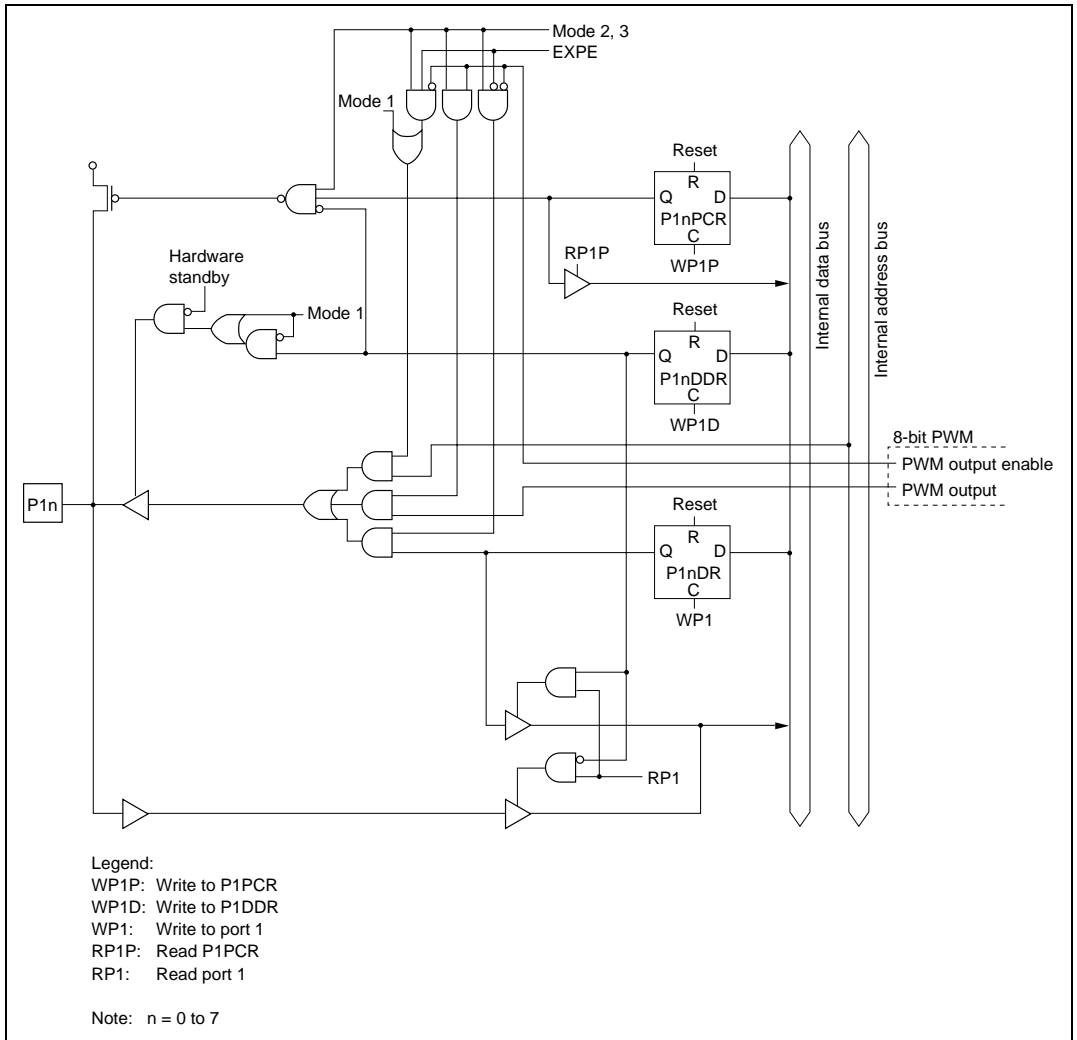


Figure C.1 Port 1 Block Diagram

C.2 Port 2 Block Diagrams

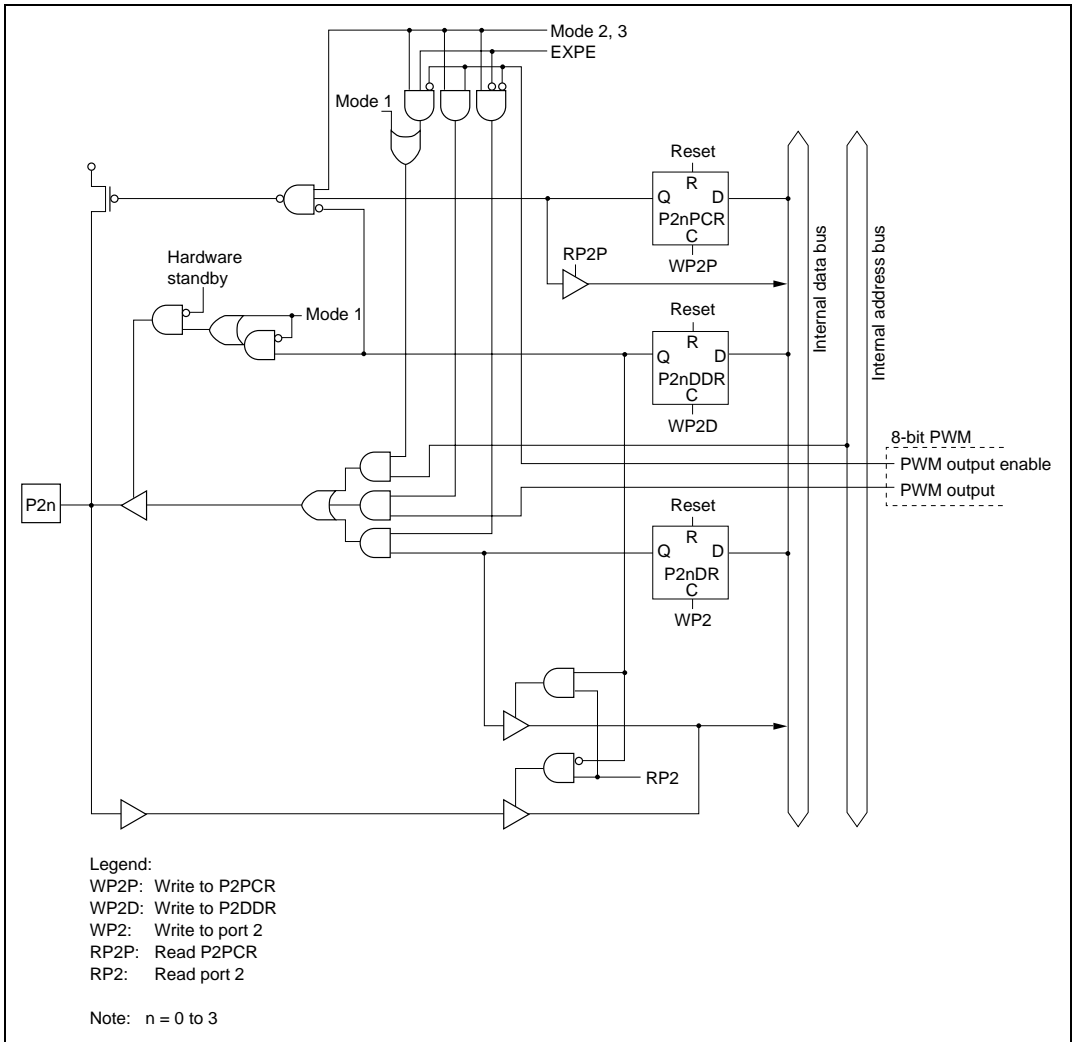


Figure C.2 Port 2 Block Diagram (Pins P20 to P23)

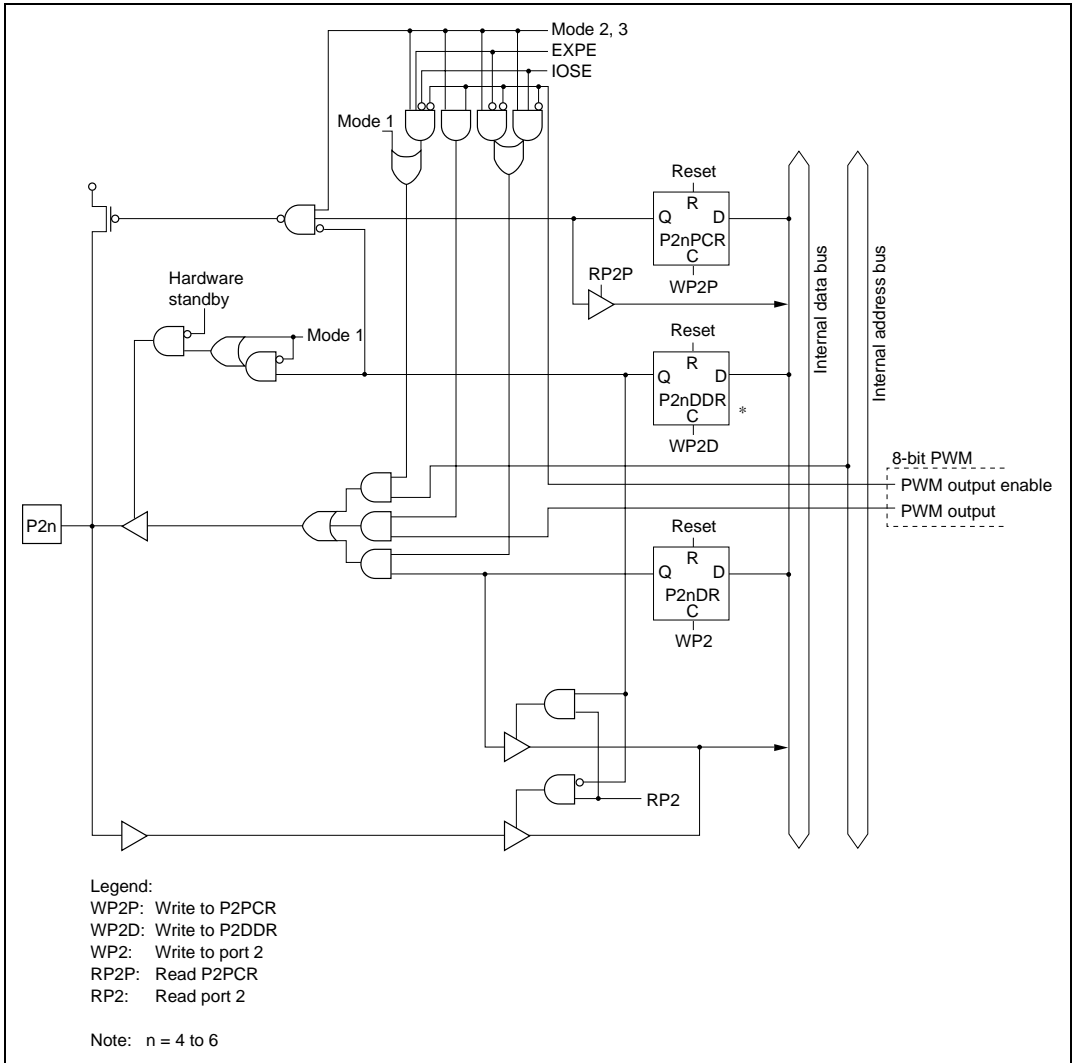


Figure C.3 Port 2 Block Diagram (Pins P24 to P26)

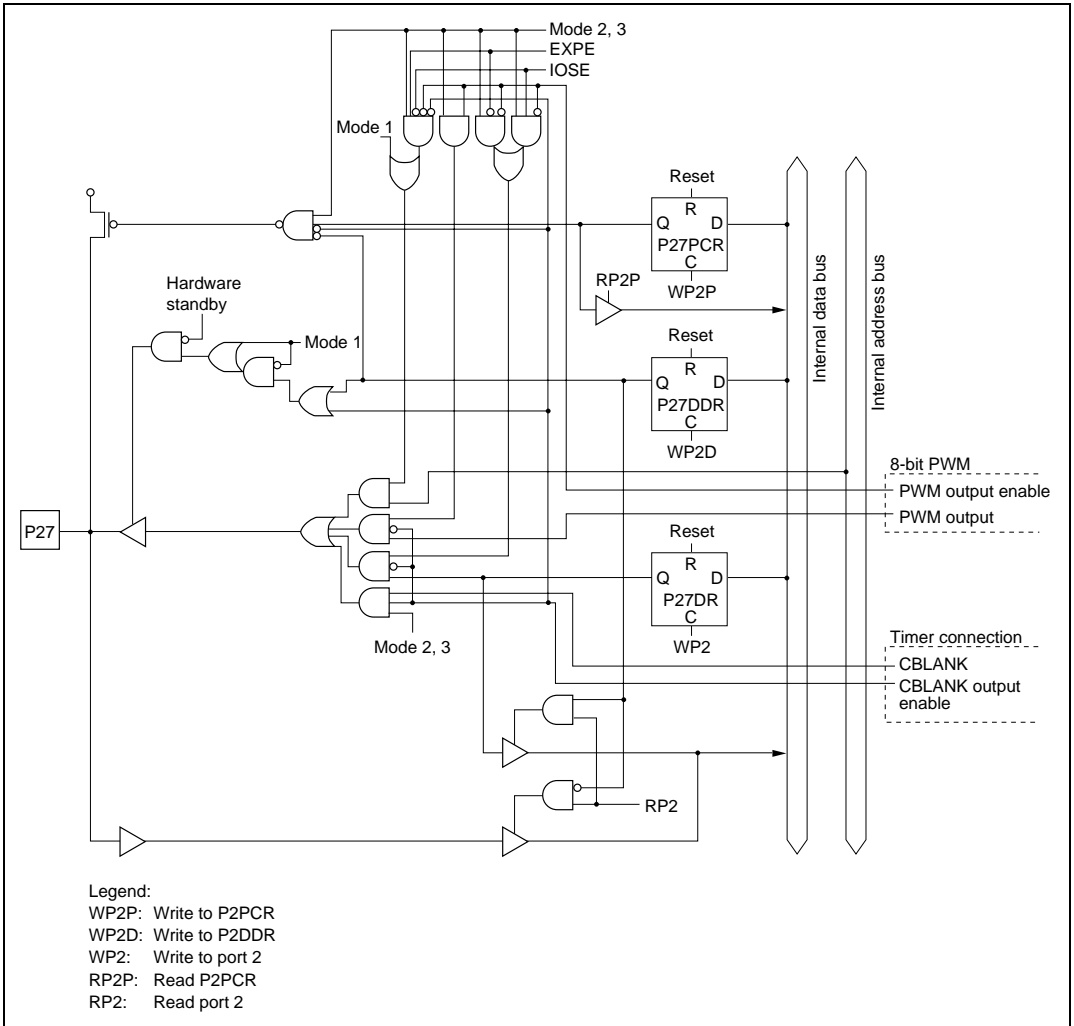


Figure C.4 Port 2 Block Diagram (Pin P27)

C.3 Port 3 Block Diagram

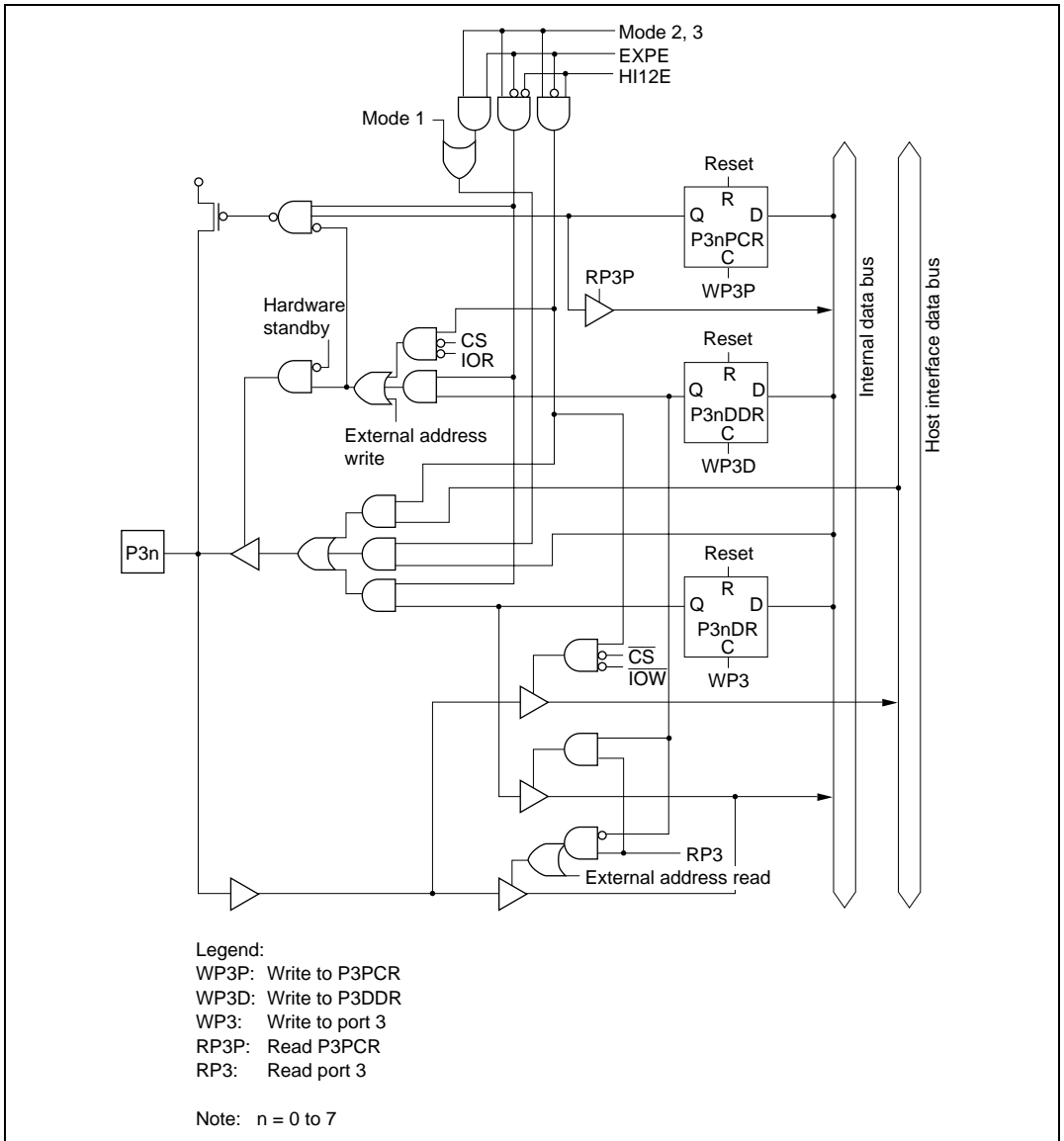


Figure C.5 Port 3 Block Diagram

C.4 Port 4 Block Diagrams

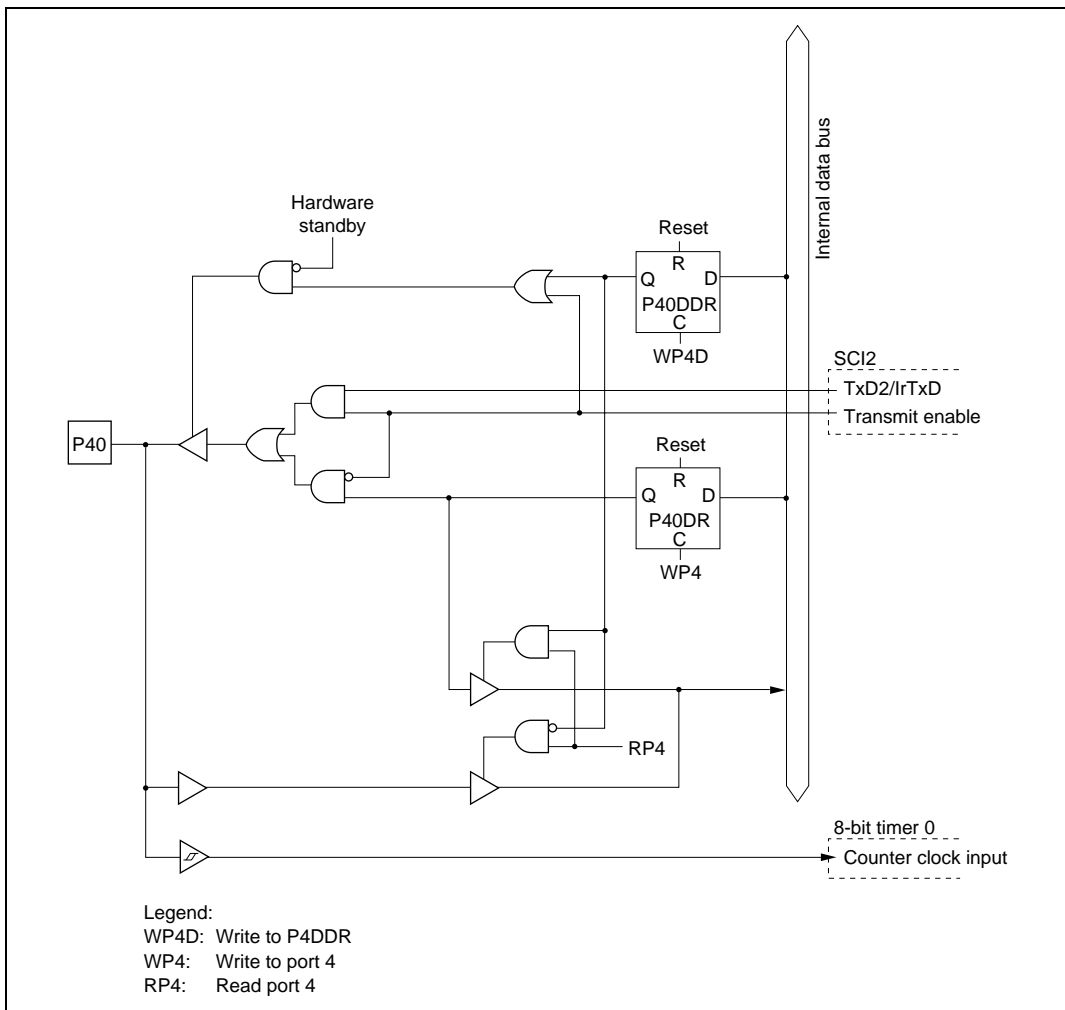


Figure C.6 Port 4 Block Diagram (Pin P40)

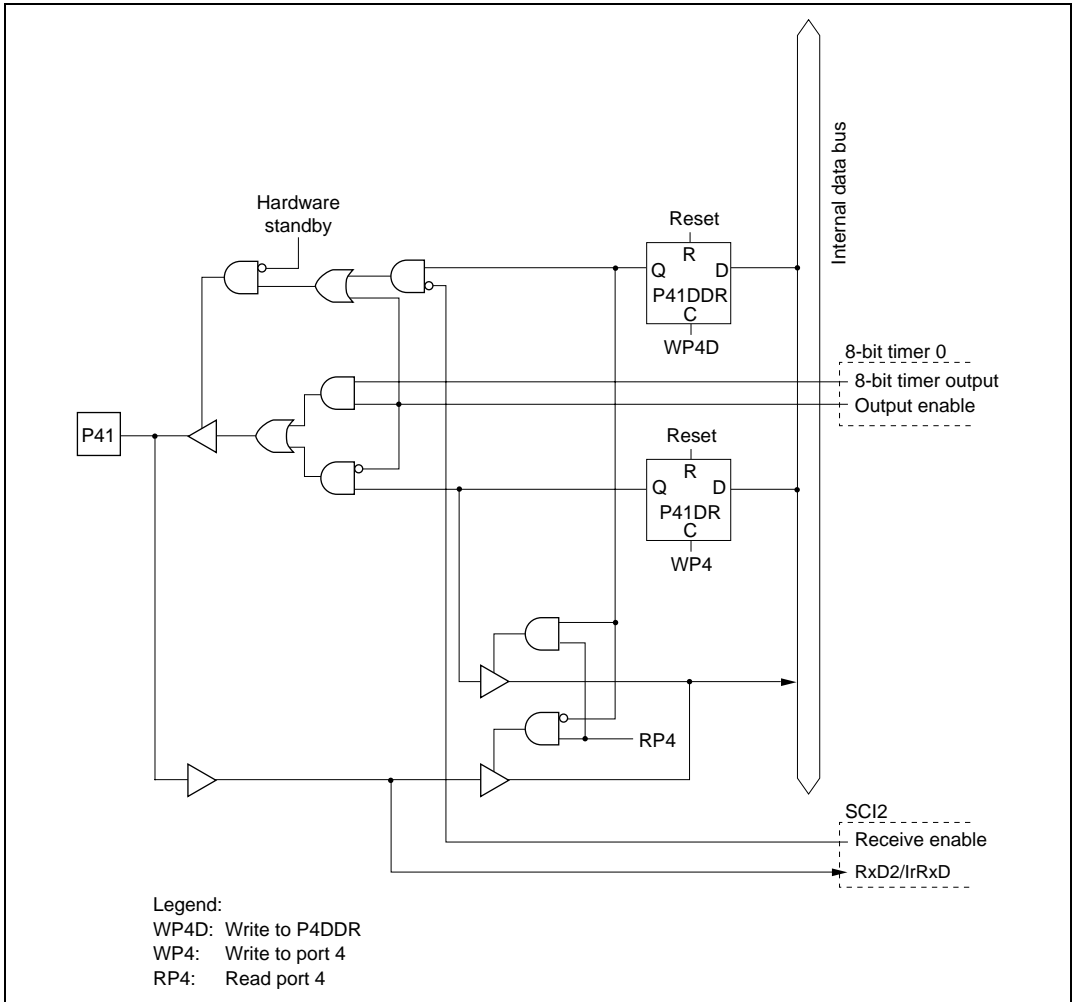


Figure C.7 Port 4 Block Diagram (Pin P41)

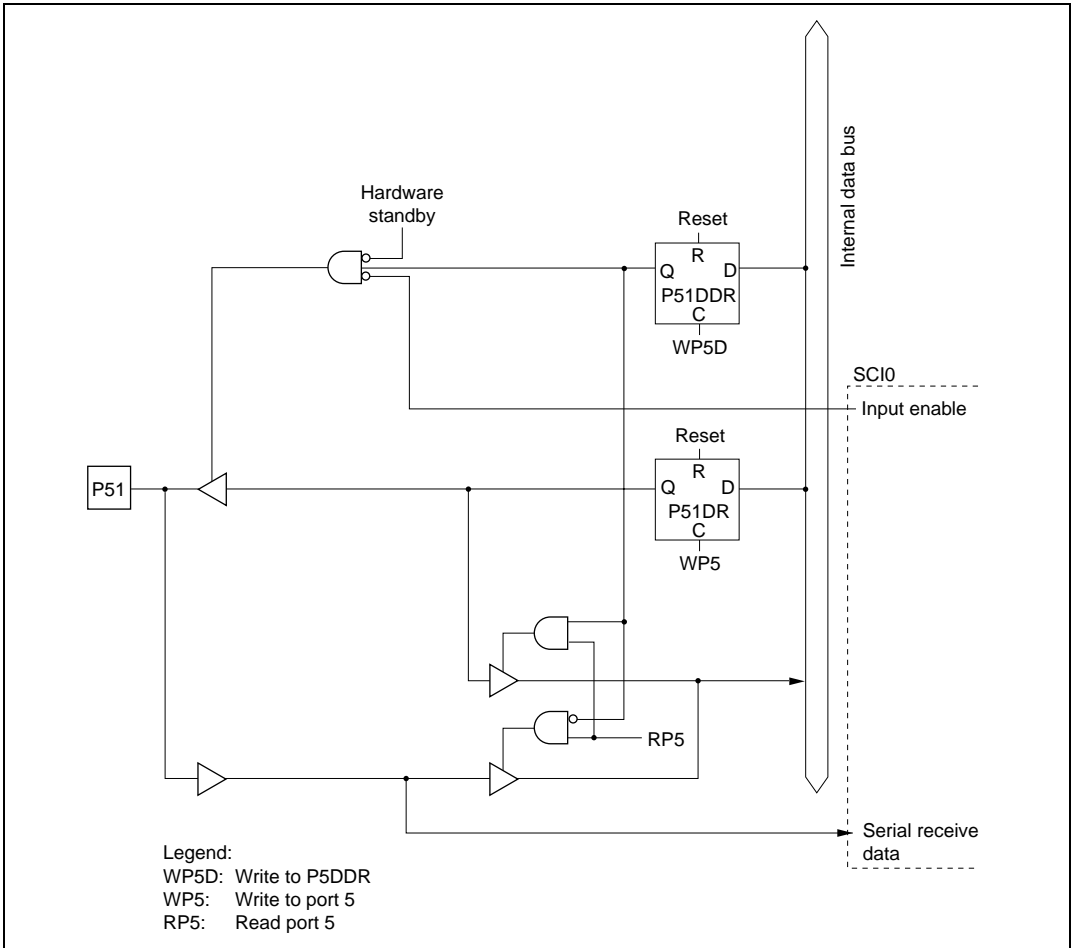


Figure C.14 Port 5 Block Diagram (Pin P51)

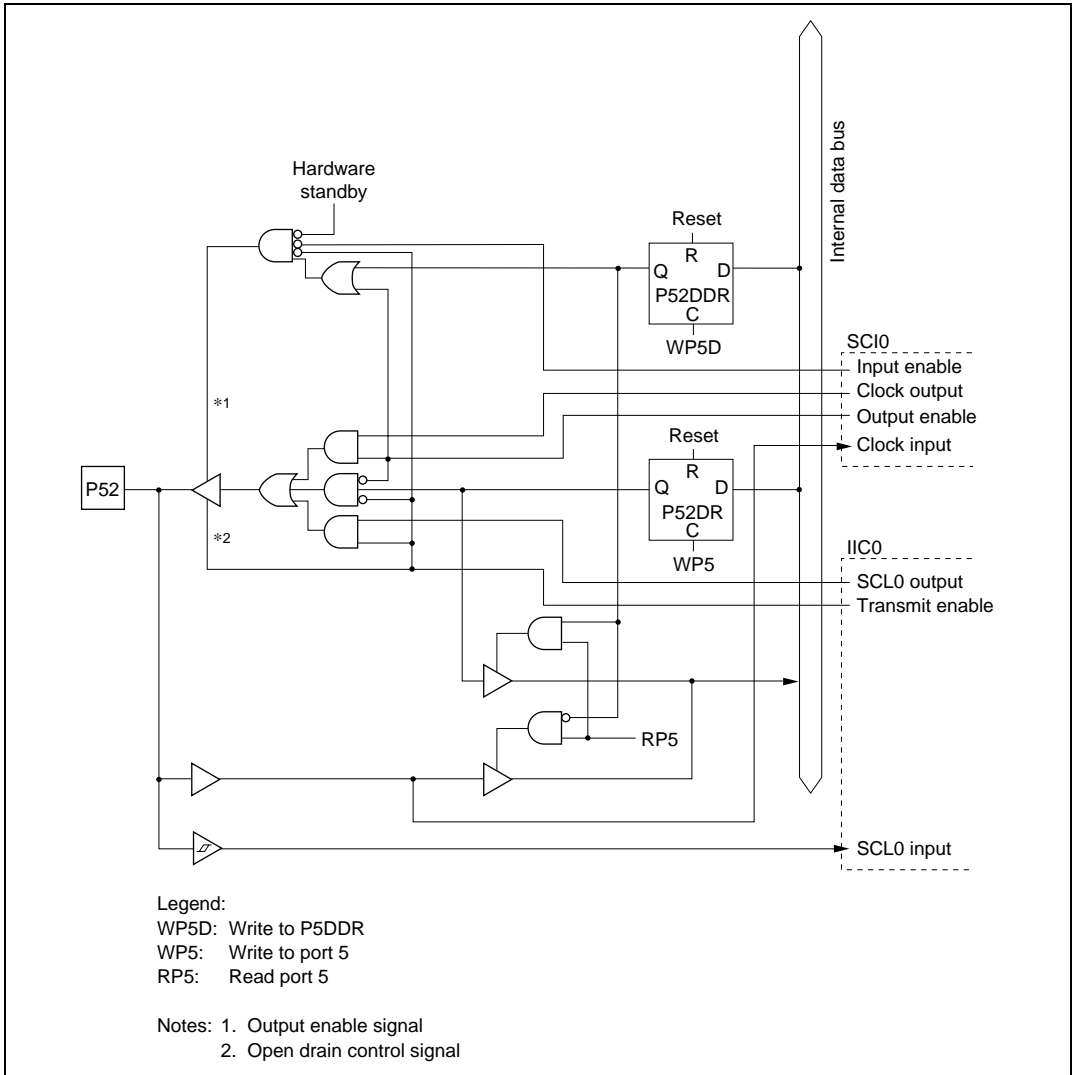


Figure C.15 Port 5 Block Diagram (Pin P52)

C.6 Port 6 Block Diagrams

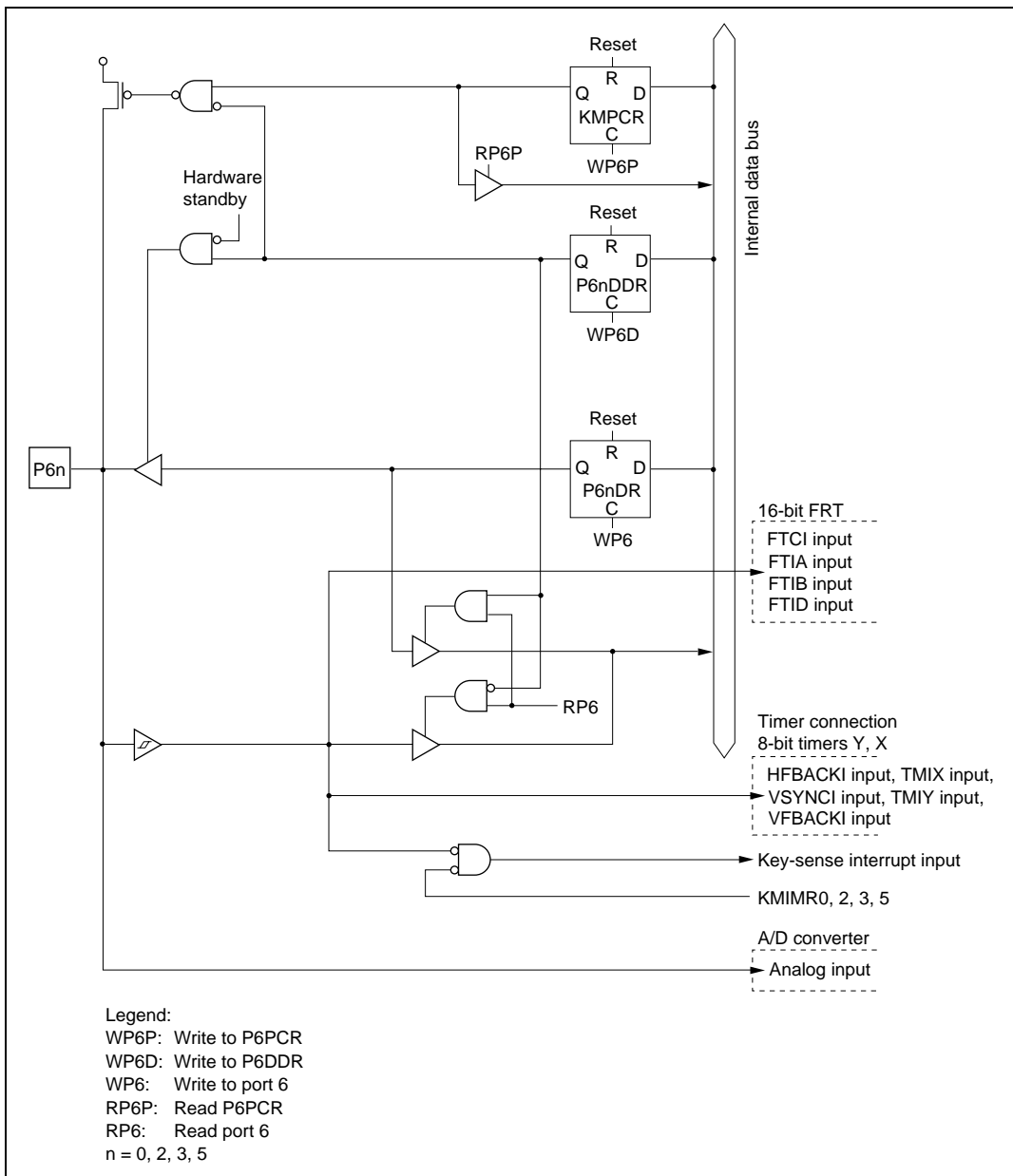


Figure C.16 Port 6 Block Diagram (Pins P60, P62, P63, P65)

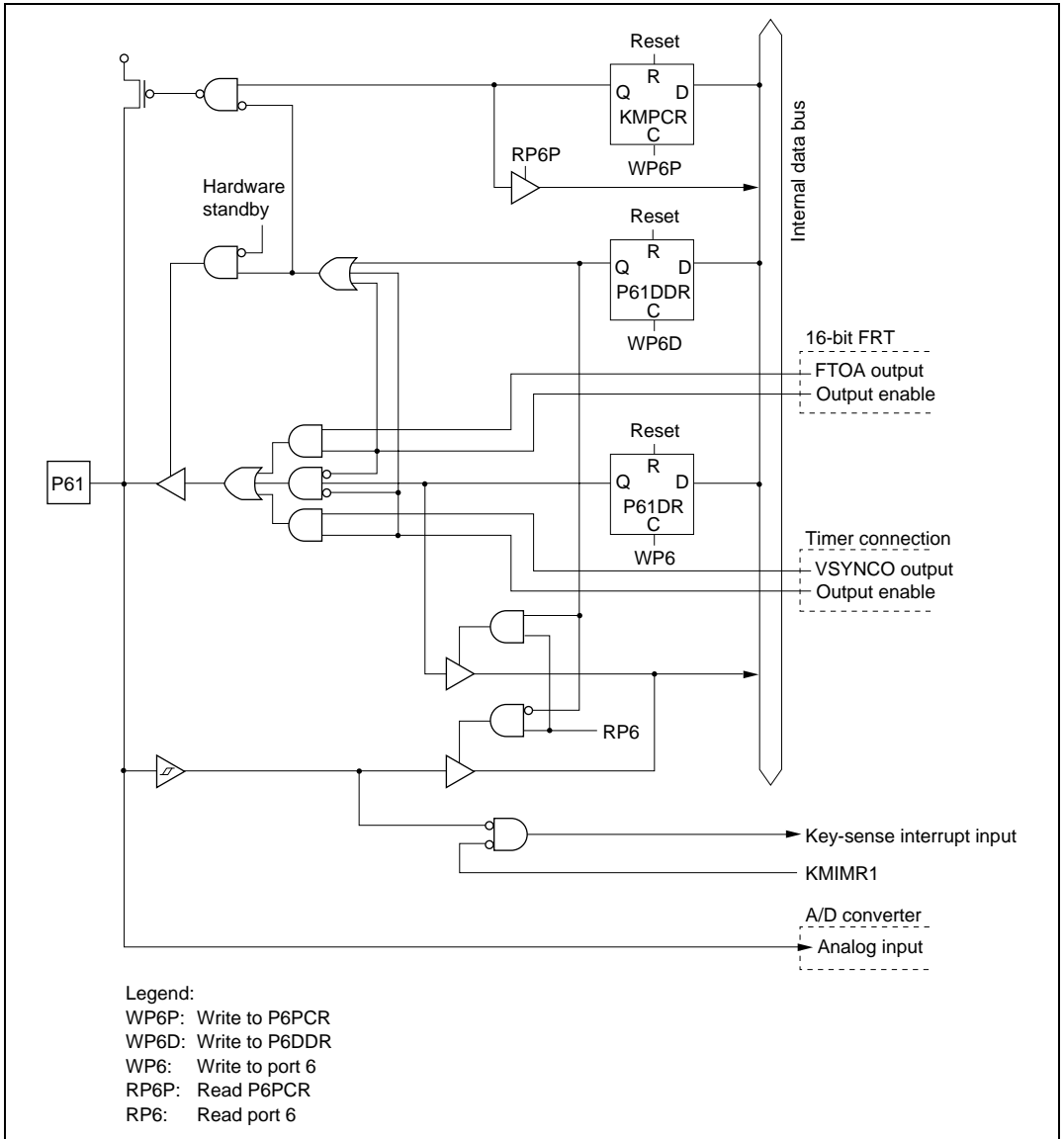


Figure C.17 Port 6 Block Diagram (Pin P61)

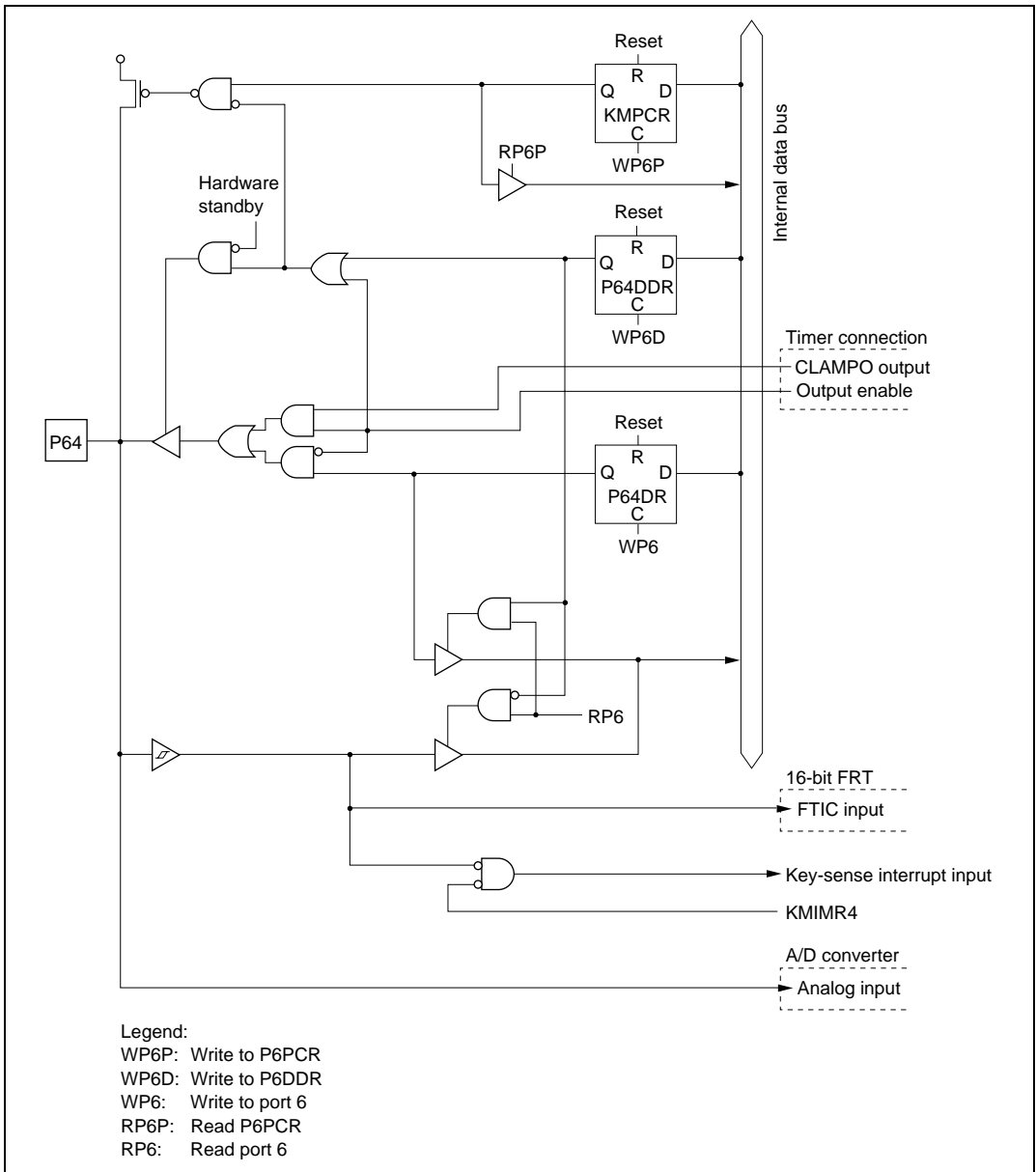


Figure C.18 Port 6 Block Diagram (Pin P64)

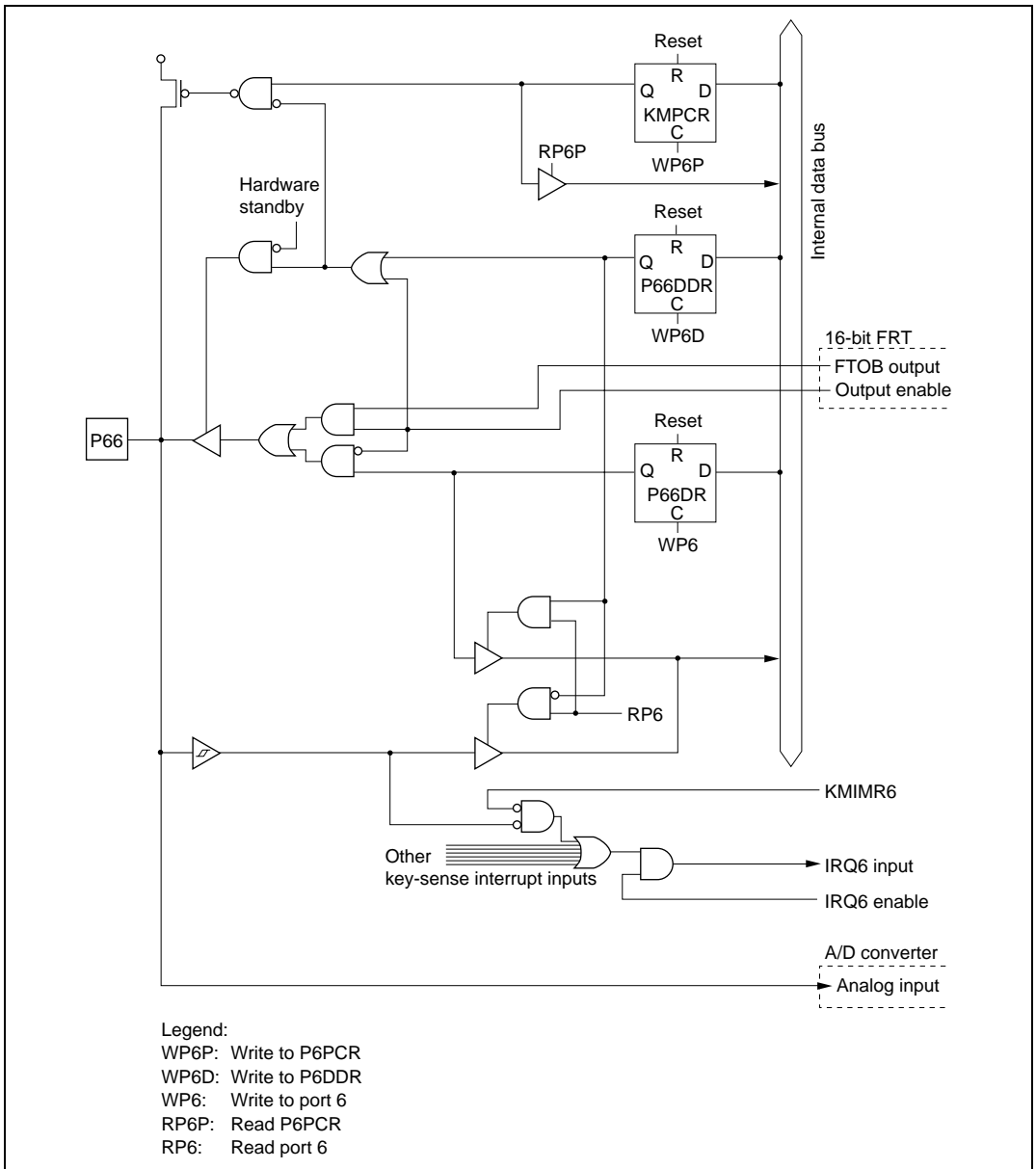


Figure C.19 Port 6 Block Diagram (Pin P66)

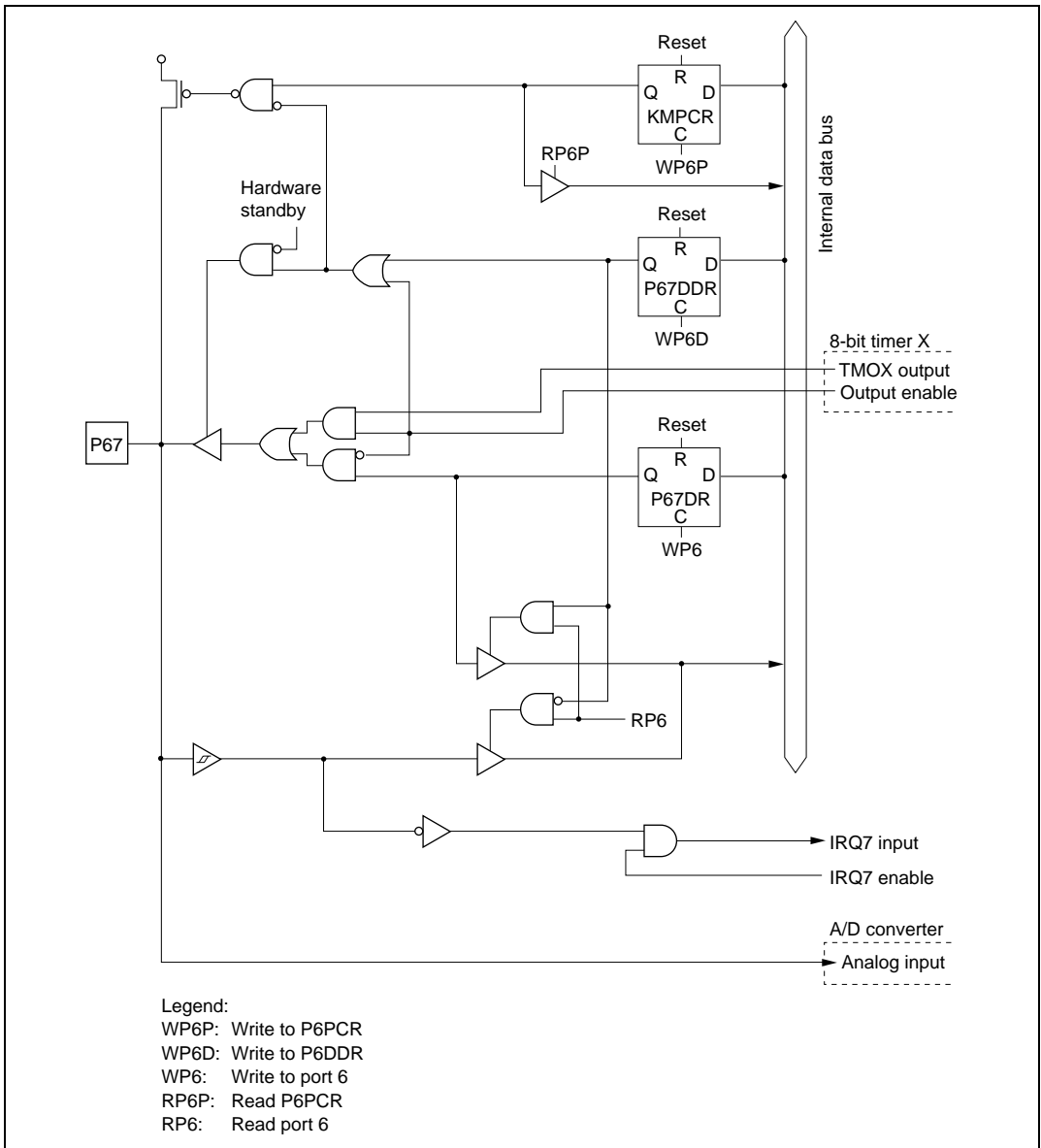


Figure C.20 Port 6 Block Diagram (Pin P67)

C.7 Port 7 Block Diagrams

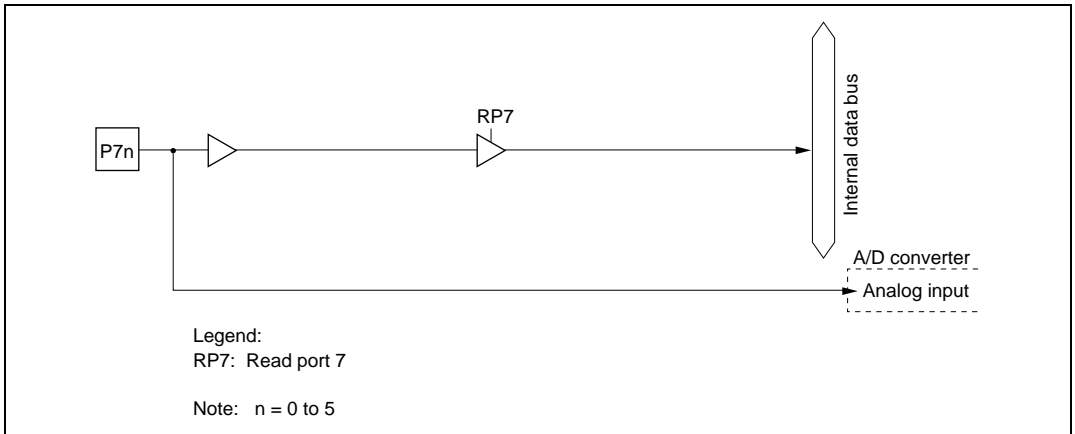


Figure C.21 Port 7 Block Diagram (Pins P70 to P75)

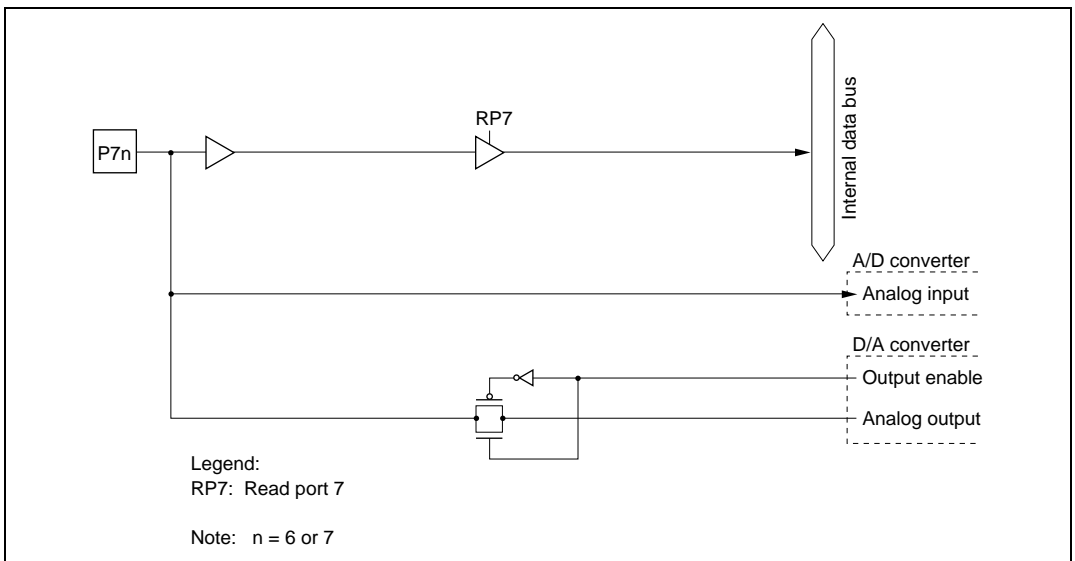


Figure C.22 Port 7 Block Diagram (Pins P76, P77)

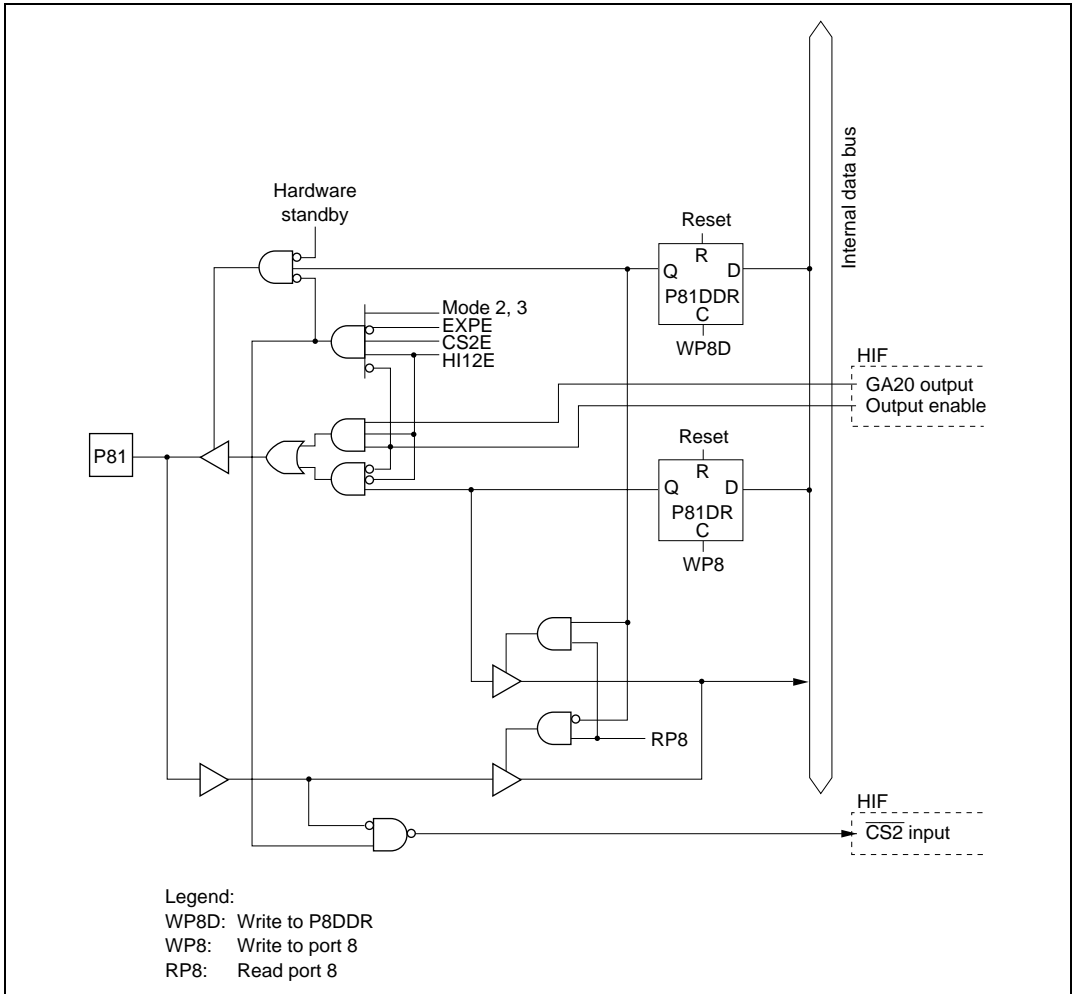


Figure C.24 Port 8 Block Diagram (Pin P81)

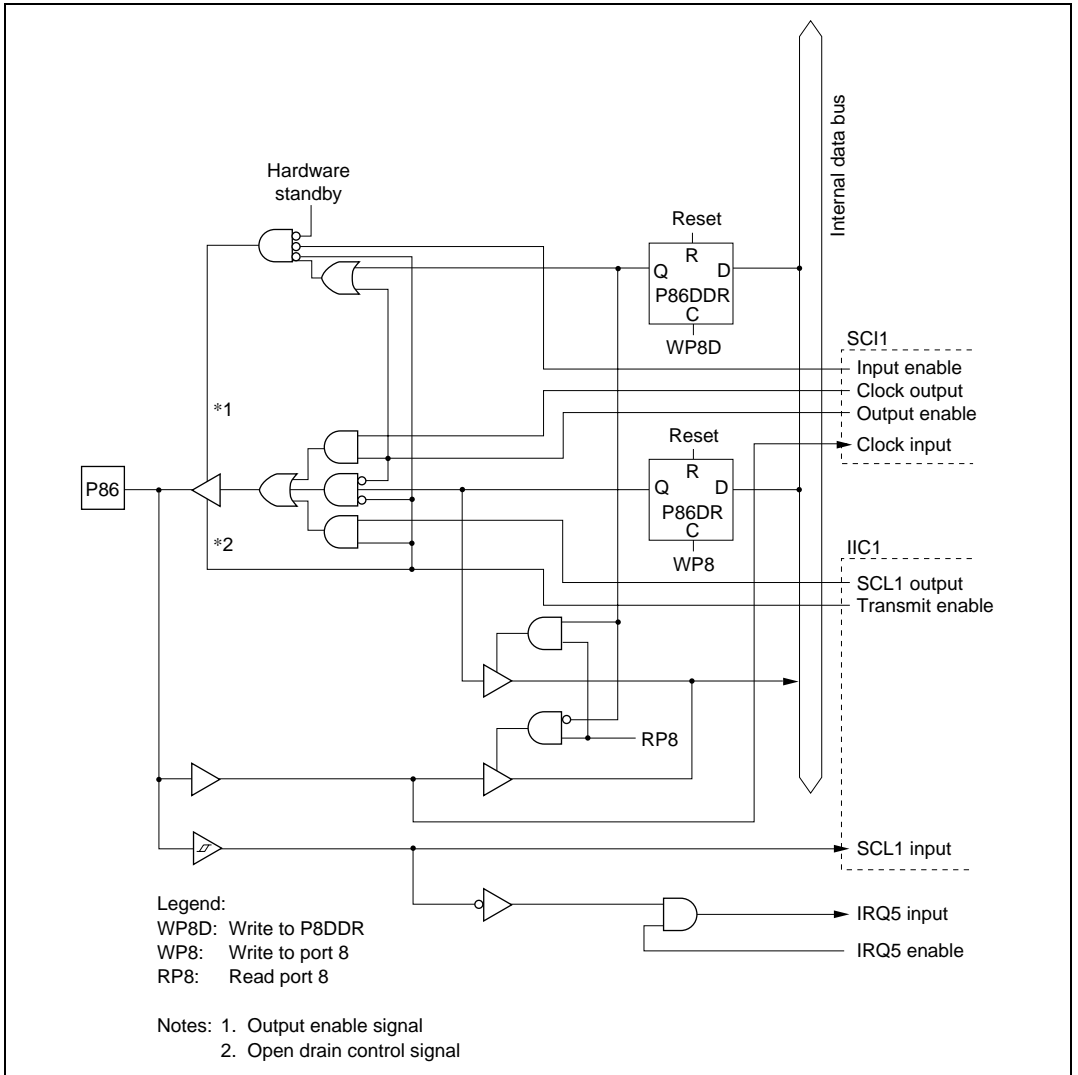


Figure C.28 Port 8 Block Diagram (Pin P86)

C.9 Port 9 Block Diagrams

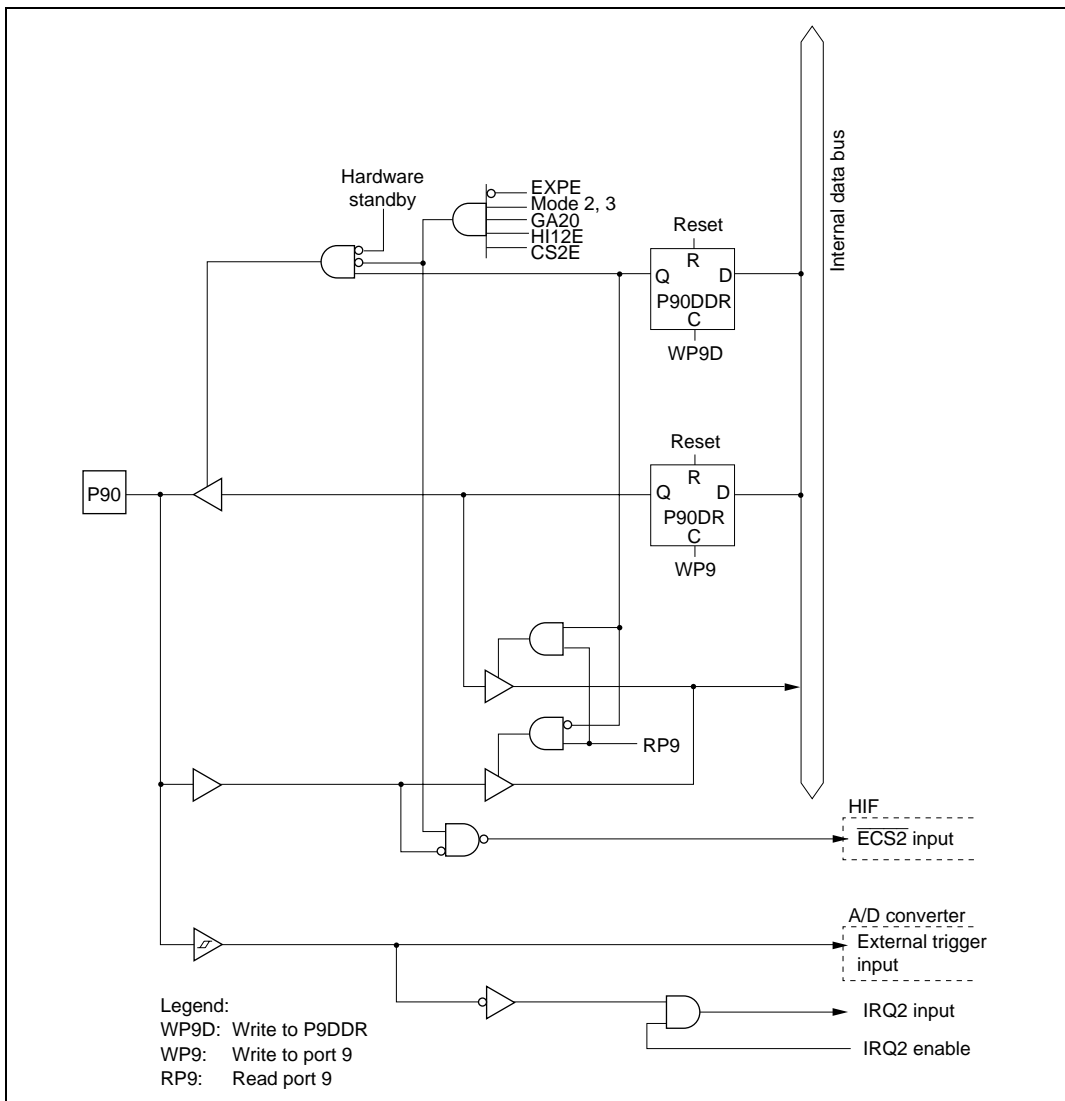


Figure C.29 Port 9 Block Diagram (Pin P90)

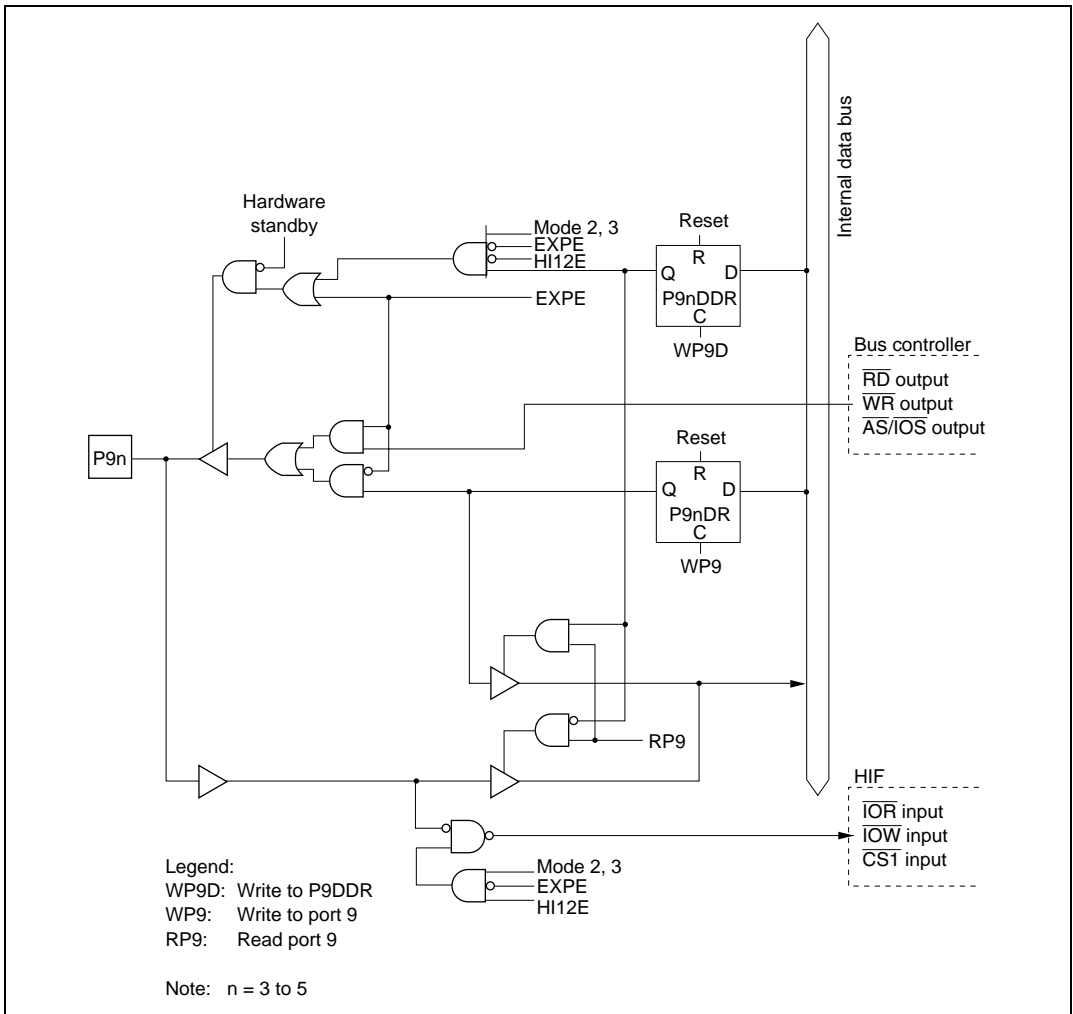


Figure C.31 Port 9 Block Diagram (Pins P93 to P95)

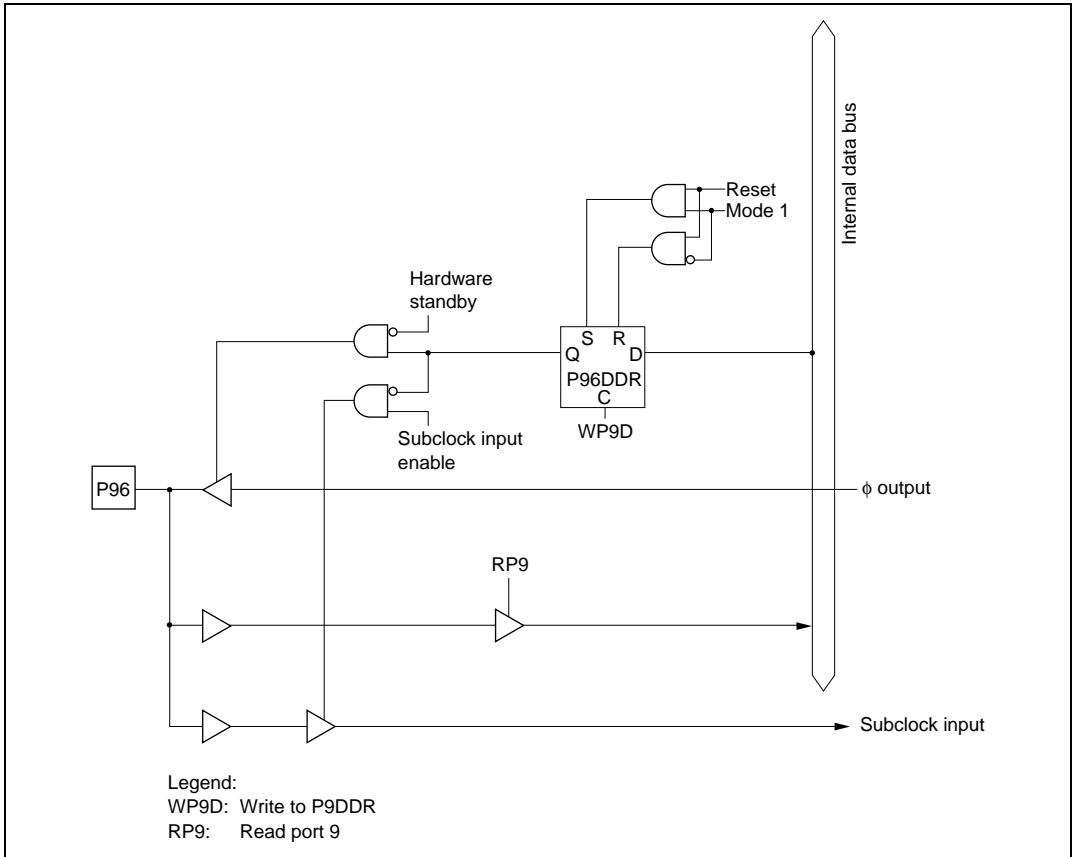


Figure C.32 Port 9 Block Diagram (Pin P96)

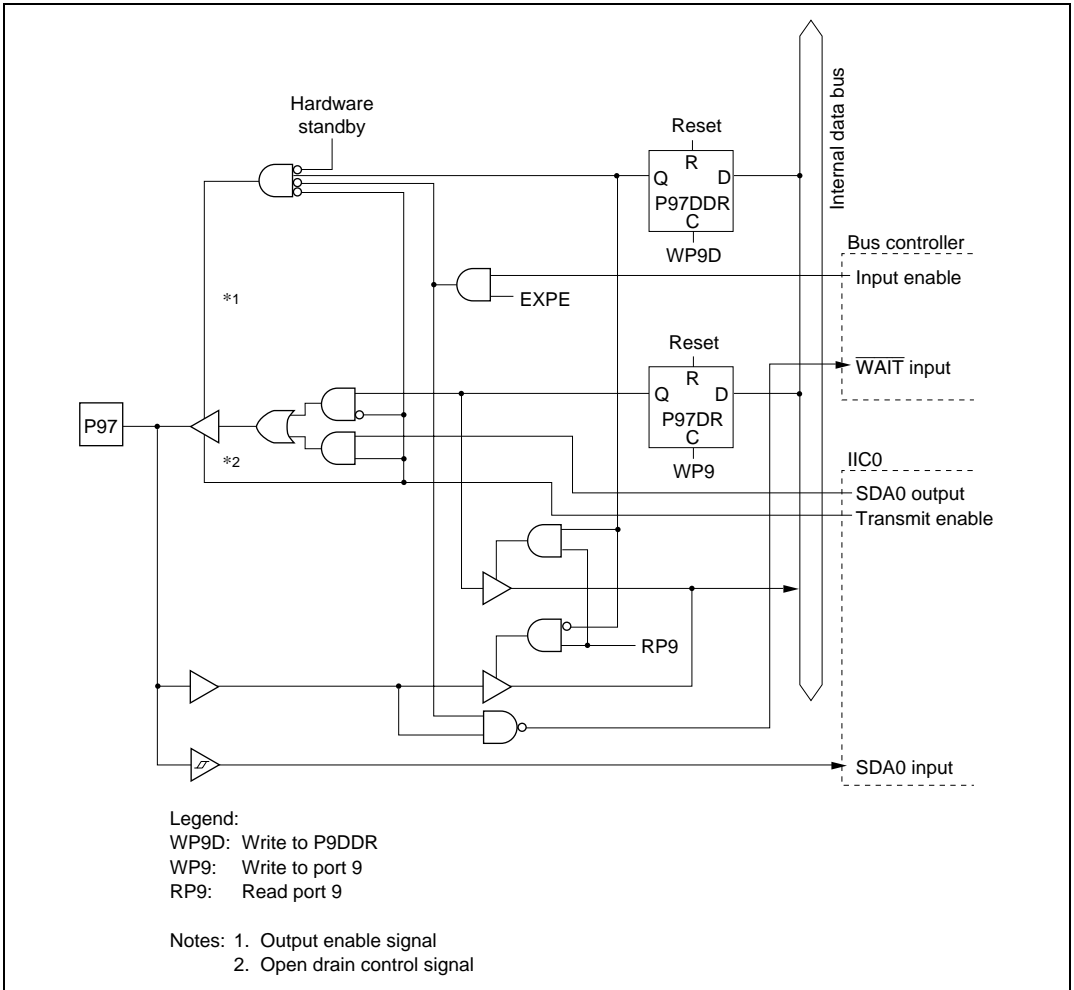


Figure C.33 Port 9 Block Diagram (Pin P97)

Appendix D Pin States

D.1 Port States in Each Processing State

Table D.1 I/O Port States in Each Processing State

| Port Name Pin Name | MCU Operating Mode | Reset | Hardware Standby Mode | Software Standby Mode | Watch Mode | Sleep Mode | Sub- sleep Mode | Subactive Mode | Program Execution State |
|-----------------------|-----------------------|-------|-----------------------------|-----------------------------|---------------|---------------|-----------------------|----------------------------------|----------------------------------|
| Port 1 A7 to A0 | 1 | L | T | keep* | keep* | keep* | keep* | A7 to A0 | A7 to A0 |
| | 2, 3 (EXPE = 1) | T | | | | | | Address output/ input port | Address output/ input port |
| | 2, 3 (EXPE = 0) | | | | | | | I/O port | I/O port |
| Port 2 A15 to A8 | 1 | L | T | keep* | keep* | keep* | keep* | A15 to A8 | A15 to A8 |
| | 2, 3 (EXPE = 1) | T | | | | | | Address output/ input port | Address output/ input port |
| | 2, 3 (EXPE = 0) | | | | | | | I/O port | I/O port |
| Port 3 D7 to D0 | 1 | T | T | T | T | T | T | D7 to D0 | D7 to D0 |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | keep | keep | keep | keep | I/O port | I/O port |
| Port 4 | 1 | T | T | keep | keep | keep | keep | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 5 | 1 | T | T | keep | keep | keep | keep | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 6 | 1 | T | T | keep | keep | keep | keep | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 7 | 1 | T | T | T | T | T | T | Input port | Input port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 8 | 1 | T | T | keep | keep | keep | keep | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 97 WAIT | 1 | T | T | T/keep | T/keep | T/keep | T/keep | WAIT/ I/O port | WAIT/ I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | keep | keep | keep | keep | I/O port | I/O port |

| Port Name Pin Name | MCU Operating Mode | Reset | Hardware Standby Mode | Software Standby Mode | Watch Mode | Sleep Mode | Sub- sleep Mode | Subactive Mode | Program Execution State |
|-----------------------------|-----------------------|-----------------|-----------------------------|-----------------------------|---------------|---|-----------------------|-------------------|--|
| Port 96 ϕ EXCL | 1 | Clock output | T | [DDR = 1] H [DDR = 0] T | EXCL input | [DDR = 1] clock output [DDR = 0] T | EXCL input | EXCL input | Clock output/ EXCL input/ input port |
| | 2, 3 (EXPE = 1) | T | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 95 to 93 AS, WR, RD | 1 | H | T | H | H | H | H | AS, WR, RD | AS, WR, RD |
| | 2, 3 (EXPE = 1) | T | | | | | | | |
| | 2, 3 (EXPE = 0) | | | keep | keep | keep | keep | I/O port | I/O port |
| Port 92 to 90 | 1 | T | T | keep | keep | keep | keep | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |

Legend:

H: High

L: Low

T: High-impedance state

keep: Input ports are in the high-impedance state (when DDR = 0 and PCR = 1, MOS input pull-ups remain on).

Output ports maintain their previous state.

Depending on the pins, the on-chip supporting modules may be initialized and the I/O port function determined by DDR and DR used.

DDR: Data direction register

Note: * In the case of address output, the last address accessed is retained.

Appendix E Timing of Transition to and Recovery from Hardware Standby Mode

E.1 Timing of Transition to Hardware Standby Mode

- (1) To retain RAM contents with the RAME bit set to 1 in SYSCR, drive the $\overline{\text{RES}}$ signal low 10 system clock cycles before the $\overline{\text{STBY}}$ signal goes low, as shown in figure E.1. $\overline{\text{RES}}$ must remain low until $\overline{\text{STBY}}$ signal goes low (minimum delay from $\overline{\text{STBY}}$ low to $\overline{\text{RES}}$ high: 0 ns).

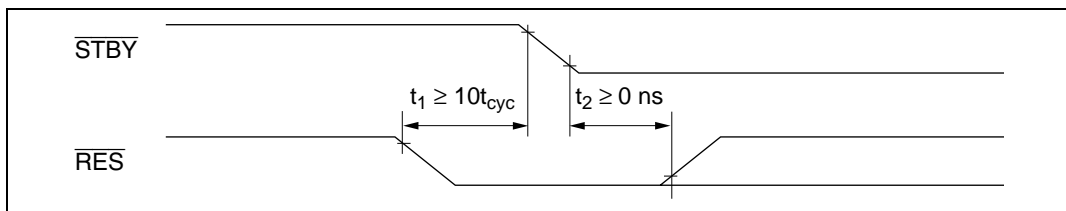


Figure E.1 Timing of Transition to Hardware Standby Mode

- (2) To retain RAM contents with the RAME bit cleared to 0 in SYSCR, or when RAM contents do not need to be retained, $\overline{\text{RES}}$ does not have to be driven low as in (1).

E.2 Timing of Recovery from Hardware Standby Mode

Drive the $\overline{\text{RES}}$ signal low at least 100 ns before $\overline{\text{STBY}}$ goes high to execute a reset.

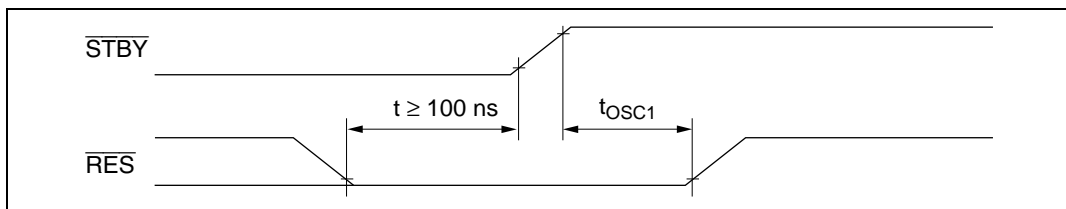


Figure E.2 Timing of Recovery from Hardware Standby Mode

Appendix F Product Code Lineup

Table F.1 H8S/2138 Group and H8S/2134 Group Product Code Lineup

| Product Type | | | | Product Code | Mark Code | Package (Package Code) |
|---|----------------|---|---|-----------------------|-----------------------|------------------------|
| H8S/2138 Group | H8S/2138 | Mask ROM version | Standard product (5 V version, 4 V version, 3 V version) | HD6432138S | HD6432138S(V)(***)FA | 80-pin QFP (FP-80A) |
| | | | | | HD6432138S(V)(***)TF | 80-pin TQFP (TFP-80C) |
| | | | Version with on-chip I ² C bus interface (5 V version, 4 V version, 3 V version) | HD6432138SW | HD6432138S(V)W(***)FA | 80-pin QFP (FP-80A) |
| | | | | | HD6432138S(V)W(***)TF | 80-pin TQFP (TFP-80C) |
| | F-ZTAT version | Standard product (5 V version, 4 V version) | HD64F2138 | HD64F2138FA20 | 80-pin QFP (FP-80A) | |
| | | Low-voltage version (3 V version) | HD64F2138V | HD64F2138VFA10 | 80-pin QFP (FP-80A) | |
| | H8S/2137 | Mask ROM version | Standard product (5 V version, 4 V version, 3 V version) | HD6432137S | HD6432137S(V)(***)FA | 80-pin QFP (FP-80A) |
| | | | | | HD6432137S(V)(***)TF | 80-pin TQFP (TFP-80C) |
| Version with on-chip I ² C bus interface (5 V version, 4 V version, 3 V version) | | | HD6432137SW | HD6432137S(V)W(***)FA | 80-pin QFP (FP-80A) | |
| | | | | HD6432137S(V)W(***)TF | 80-pin TQFP (TFP-80C) | |
| H8S/2138 Group A-mask version | H8S/2138A | F-ZTAT A-mask version | Standard product (5 V/4 V version) | HD64F2138A | HD64F2138AFA20 | 80-pin QFP (FP-80A) |
| | | | | | HD64F2138ATF20 | 80-pin TQFP (TFP-80C) |
| | | | Low-voltage version (3 V version) | HD64F2138AV | HD64F2138AVFA10 | 80-pin QFP (FP-80A) |
| | | | | | HD64F2138AVTF10 | 80-pin TQFP (TFP-80C) |

| Product Type | | | | Product Code | Mark Code | Package (Package Code) |
|-------------------------------|-----------------------------------|--|--|------------------------------------|------------------------------------|------------------------|
| H8S/2134 Group | H8S/2134 | Mask ROM version | Standard product (5 V version, 4 V version, 3 V version) | HD6432134S | HD6432134S(V)(***)FA | 80-pin QFP (FP-80A) |
| | | | | | HD6432134S(V)(***)TF | 80-pin TQFP (TFP-80C) |
| | | | | F-ZTAT version | Standard product (5 V/4 V version) | HD64F2134 |
| | | HD64F2134TF20 | 80-pin TQFP (TFP-80C) | | | |
| | Low-voltage version (3 V version) | HD64F2134V | HD64F2134VFA10 | | 80-pin QFP (FP-80A) | |
| | | | HD64F2134VTF10 | 80-pin TQFP (TFP-80C) | | |
| H8S/2133 | Mask ROM version | Standard product (5 V version, 4 V version, 3 V version) | HD6432133S | HD6432133S(V)(***)FA | 80-pin QFP (FP-80A) | |
| | | | | HD6432133S(V)(***)TF | 80-pin TQFP (TFP-80C) | |
| H8S/2132 | Mask ROM version | Standard product (5 V version, 4 V version, 3 V version) | HD6432132 | HD6432132(***)FA | 80-pin QFP (FP-80A) | |
| | | | | HD6432132(***)TF | 80-pin TQFP (TFP-80C) | |
| | | | F-ZTAT version | Standard product (5 V/4 V version) | HD64F2132R | HD64F2132RFA20 |
| | | HD64F2132RTF20 | | | 80-pin TQFP (TFP-80C) | |
| | Low-voltage version (3 V version) | HD64F2132RV | | HD64F2132RVFA10 | 80-pin QFP (FP-80A) | |
| | | | HD64F2132RVTF10 | 80-pin TQFP (TFP-80C) | | |
| H8S/2130 | Mask ROM version | Standard product (5 V version, 4 V version, 3 V version) | HD6432130 | HD6432130(***)FA | 80-pin QFP (FP-80A) | |
| | | | | HD6432130(***)TF | 80-pin TQFP (TFP-80C) | |
| H8S/2134 Group A-mask version | H8S/2134A | F-ZTAT A-mask version | Standard product (5 V/4 V version) | HD64F2134A | HD64F2134AFA20 | 80-pin QFP (FP-80A) |
| | | | | | HD64F2134ATF20 | 80-pin TQFP (TFP-80C) |
| | | | | Low-voltage version (3 V version) | HD64F2134AV | HD64F2134AVFA10 |
| | | HD64F2134AVTF10 | 80-pin TQFP (TFP-80C) | | | |

Note: (***) is the ROM code.

The F-ZTAT version of the H8S/2138 has an on-chip I²C bus interface as standard.

The F-ZTAT 5 V/4 V version supports the operating ranges of the 5 V version and the 4 V version.

The above table includes products under development. Information on the status of individual products can be obtained from Renesas' sales offices.

Appendix G Package Dimensions

Figures G.1 and G.2 show the package dimensions of the H8S/2138 Group and H8S/2134 Group.

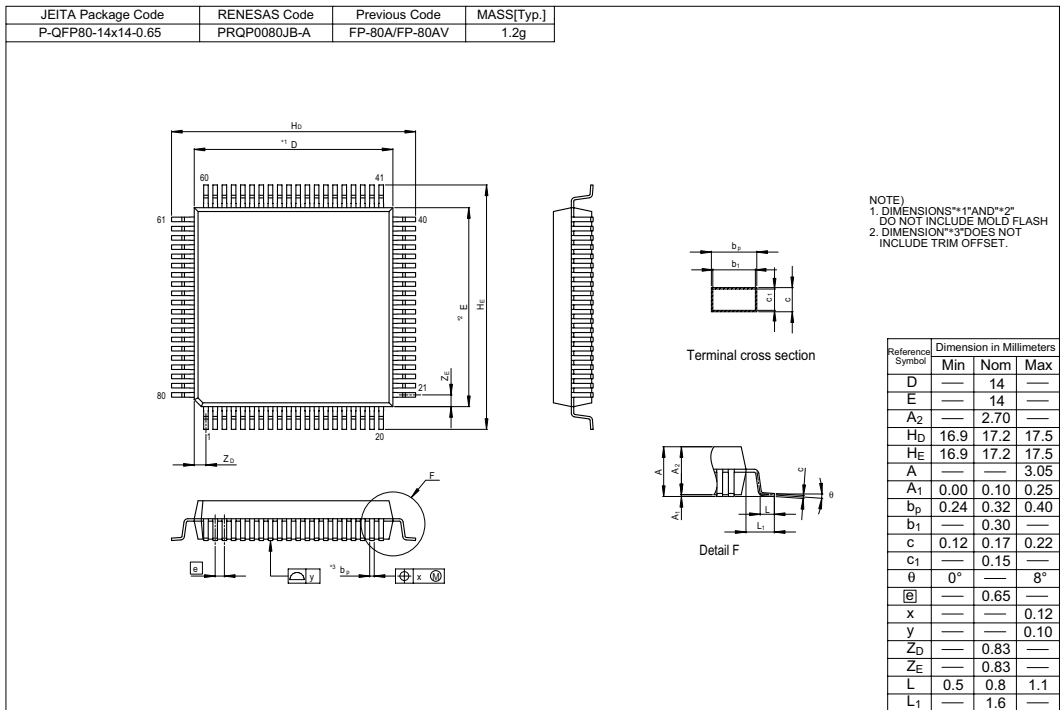
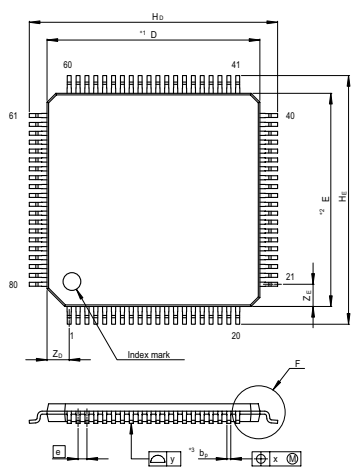
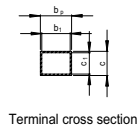


Figure G.1 Package Dimensions (FP-80A)

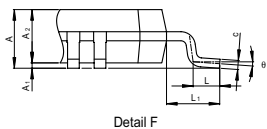
| | | | |
|---------------------|--------------|------------------|------------|
| JEITA Package Code | RENESAS Code | Previous Code | MASS[Typ.] |
| P-TQFP80-12x12-0.50 | PTQP0080KC-A | TFP-80C/TFP-80CV | 0.4g |



NOTE)
 1. DIMENSIONS *1* AND *2* DO NOT INCLUDE MOLD FLASH
 2. DIMENSION *3* DOES NOT INCLUDE TRIM OFFSET.



Terminal cross section



Detail F

| Reference Symbol | Dimension in Millimeters | | |
|------------------|--------------------------|------|------|
| | Min | Nom | Max |
| D | — | 12 | — |
| E | — | 12 | — |
| A ₂ | — | 1.00 | — |
| H ₀ | 13.8 | 14.0 | 14.2 |
| H ₁ | 13.8 | 14.0 | 14.2 |
| A | — | — | 1.20 |
| A ₁ | 0.00 | 0.10 | 0.20 |
| b _p | 0.17 | 0.22 | 0.27 |
| b ₁ | — | 0.20 | — |
| c | 0.12 | 0.17 | 0.22 |
| c ₁ | — | 0.15 | — |
| θ | 0° | — | 8° |
| ⓐ | — | 0.5 | — |
| x | — | — | 0.10 |
| y | — | — | 0.10 |
| Z _D | — | 1.25 | — |
| Z _E | — | 1.25 | — |
| L | 0.4 | 0.5 | 0.6 |
| L ₁ | — | 1.0 | — |

Figure G.2 Package Dimensions (TFP-80C)

**Renesas 16-Bit Single-Chip Microcomputer
Hardware Manual
H8S/2138 Group, H8S/2134 Group,
H8S/2138F-ZTAT™, H8S/2134F-ZTAT™, H8S/2132F-ZTAT™**

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Edited by: Customer Support Department

Global Strategic Communication Div.

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